MOTOROLA
intelligence everywhere™

digital dna™

MPC8245UM
10/2003
Rev. 2

MPC8245 Integrated Processor User's Manual

HOW TO REACH US:

USA/EUROPE/LOCATIONS NOT LISTED:

Motorola Literature Distribution
P.O. Box 5405, Denver, Colorado 80217
1-480-768-2130
(800) 521-6274

JAPAN:

Motorola Japan Ltd.
SPS, Technical Information Center
3-20-1, Minami-Azabu Minato-ku
Tokyo 106-8573 Japan
81-3-3440-3569

ASIA/PACIFIC:

Motorola Semiconductors H.K. Ltd.
Silicon Harbour Centre, 2 Dai King Street
Tai Po Industrial Estate, Tai Po, N.T., Hong Kong
852-26668334

TECHNICAL INFORMATION CENTER:

(800) 521-6274

HOME PAGE:

www.motorola.com/semiconductors

Information in this document is provided solely to enable system and software implementers to use Motorola products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. “Typical” parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including “Typicals” must be validated for each customer application by customer’s technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part.

Motorola and the Stylized M Logo are registered in the U.S. Patent and Trademark Office. digital dna is a trademark of Motorola, Inc. The described product is a PowerPC microprocessor. The PowerPC name is a trademark of IBM Corp. and used under license. TUNDRA is a registered trademark of Tundra Semiconductor Corporation (Canada, U.S., and U.K.). TUNDRA, the Tundra logo, Tsi106, Tsi107, and Silicon Behind the Network are all trademarks of Tundra Semiconductor Corporation. All other product or service names are the property of their respective owners. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

© Motorola, Inc. 2003

Overview 1
Signal Descriptions and Clocking 2
Address Maps 3
Configuration Registers 4
Processor Core 5
Memory Interface 6
PCI Bus Interface 7
DMA Controller 8
Message Unit (I_2O) 9
I^2C Interface 10
PIC 11
DUART 12
Central Control Unit 13
Error Handling 14
Power Management 15
Performance Monitor 16
Debug Features 17
Programmable I/O and Watchpoint 18

Bit and Byte Ordering A
Initialization Example B
Instruction Set C
Processor Core Register Summary D
Revision History E

Glossary of Terms and Abbreviations GLO
Index IND

1 Overview
2 Signal Descriptions and Clocking
3 Address Maps
4 Configuration Registers
5 Processor Core
6 Memory Interface
7 PCI Bus Interface
8 DMA Controller
9 Message Unit (I_2O)
10 I^2C Interface
11 PIC
12 DUART
13 Central Control Unit
14 Error Handling
15 Power Management
16 Performance Monitor
17 Debug Features
18 Programmable I/O and Watchpoint

A Bit and Byte Ordering
B Initialization Example
C Instruction Set
D Processor Core Register Summary
E Revision History

GLO Glossary of Terms and Abbreviations
IND Index

Contents

Paragraph Number	Title	Page Number
	About This Book	
	Audience	xliii
	Organization	xliv
	Suggested Reading	xlv
	General Information	xlv
	Related Documentation	xlvi
	Conventions	xlvii
	Acronyms and Abbreviations	xlviii
	Chapter 1 Overview	
1.1	MPC8245 Integrated Processor Overview	1-1
1.1.1	MPC8245 Integrated Processor Features	1-4
1.1.2	MPC8245 Integrated Processor Applications	1-6
1.2	Processor Core Overview	1-9
1.2.1	Execution Units	1-10
1.2.2	Data Types	1-12
1.2.3	Caching	1-12
1.2.4	Bus Operation	1-12
1.3	Peripheral Logic Bus	1-12
1.4	Peripheral Logic Overview	1-14
1.4.1	Memory System Interface	1-15
1.4.2	Peripheral Component Interconnect (PCI) Interface	1-16
1.4.2.1	PCI Agent Capability	1-17
1.4.2.2	PCI Bus Arbitration Unit	1-17
1.4.2.3	Address Maps and Translation	1-17
1.4.2.4	Byte Ordering	1-18
1.4.2.5	Bus Clock Buffers and Bus Ratios	1-18
1.4.3	DMA Controller	1-18
1.4.4	Message Unit (MU)	1-18
1.4.4.1	Doorbell Registers	1-18
1.4.4.2	Inbound and Outbound Message Registers	1-19
1.4.4.3	Intelligent Input/Output Controller (I_2O)	1-19
1.4.5	Inter-Integrated Circuit (I^2C) Controller	1-19

Contents

Paragraph Number	Title	Page Number
1.4.6	Programmable Interrupt Controller (PIC)	1-20
1.4.7	Dual Universal Asynchronous Receiver/Transmitter (DUART)	1-20
1.4.8	Integrated PCI Bus and SDRAM Clock Generation	1-21
1.4.9	Performance Monitor	1-21
1.5	Power Management	1-22
1.5.1	Programmable Processor Power Management Modes	1-22
1.5.2	Programmable Peripheral Logic Power Management Modes	1-23
1.6	Programmable I/O Signals with Watchpoint	1-24
1.7	Debug Features	1-24
1.7.1	Memory Attribute and PCI Attribute Signals	1-24
1.7.2	Memory Debug Address	1-24
1.7.3	Memory Interface Valid (MIV)	1-25
1.7.4	Error Injection/Capture on Data Path	1-25
1.7.5	IEEE 1149.1 (JTAG)/Test Interface	1-25
1.8	Differences Between the MPC8245 and the MPC8240	1-25

Chapter 2
Signal Descriptions and Clocking

2.1	Signal Overview	2-1
2.1.1	Signal Cross Reference	2-4
2.1.2	Output Signal States During Reset	2-7
2.2	Detailed Signal Descriptions	2-8
2.2.1	PCI Interface Signals	2-8
2.2.1.1	PCI Bus Request ($\overline{\text{REQ}}$[4:0])—Input	2-9
2.2.1.1.1	PCI Bus Request ($\overline{\text{REQ}}$[4:0])—Internal Arbiter Enabled	2-9
2.2.1.1.2	PCI Bus Request ($\overline{\text{REQ}}$[4:0])—Internal Arbiter Disabled	2-9
2.2.1.2	PCI Bus Grant ($\overline{\text{GNT}}$[4:0])—Output	2-9
2.2.1.2.1	PCI Bus Grant ($\overline{\text{GNT}}$[4:0])—Internal Arbiter Enabled	2-10
2.2.1.2.2	PCI Bus Grant ($\overline{\text{GNT}}$[4:0])—Internal Arbiter Disabled	2-10
2.2.1.3	PCI Address/Data Bus (AD[31:0])	2-10
2.2.1.3.1	Address/Data (AD[31:0])—Output	2-10
2.2.1.3.2	Address/Data (AD[31:0])—Input	2-11
2.2.1.4	Parity (PAR)	2-11
2.2.1.4.1	Parity (PAR)—Output	2-11
2.2.1.4.2	Parity (PAR)—Input	2-11
2.2.1.5	Command/Byte Enable ($\overline{\text{C/BE}}$[3:0])	2-11
2.2.1.5.1	Command/Byte Enable ($\overline{\text{C/BE}}$[3:0])—Output	2-11
2.2.1.5.2	Command/Byte Enable ($\overline{\text{C/BE}}$[3:0])—Input	2-12
2.2.1.6	Device Select ($\overline{\text{DEVSEL}}$)	2-12
2.2.1.6.1	Device Select ($\overline{\text{DEVSEL}}$)—Output	2-13
2.2.1.6.2	Device Select ($\overline{\text{DEVSEL}}$)—Input	2-13

Contents

Paragraph Number	Title	Page Number
2.2.1.7	Frame ($\overline{\text{FRAME}}$)	2-13
2.2.1.7.1	Frame ($\overline{\text{FRAME}}$)—Output	2-13
2.2.1.7.2	Frame ($\overline{\text{FRAME}}$)—Input	2-13
2.2.1.8	Initiator Ready ($\overline{\text{IRDY}}$)	2-14
2.2.1.8.1	Initiator Ready ($\overline{\text{IRDY}}$)—Output	2-14
2.2.1.8.2	Initiator Ready ($\overline{\text{IRDY}}$)—Input	2-14
2.2.1.9	Lock ($\overline{\text{LOCK}}$)—Input	2-14
2.2.1.10	Target Ready ($\overline{\text{TRDY}}$)	2-15
2.2.1.10.1	Target Ready ($\overline{\text{TRDY}}$)—Output	2-15
2.2.1.10.2	Target Ready ($\overline{\text{TRDY}}$)—Input	2-15
2.2.1.11	Parity Error ($\overline{\text{PERR}}$)	2-15
2.2.1.11.1	Parity Error ($\overline{\text{PERR}}$)—Output	2-16
2.2.1.11.2	Parity Error ($\overline{\text{PERR}}$)—Input	2-16
2.2.1.12	System Error ($\overline{\text{SERR}}$)	2-16
2.2.1.12.1	System Error ($\overline{\text{SERR}}$)—Output	2-16
2.2.1.12.2	System Error ($\overline{\text{SERR}}$)—Input	2-16
2.2.1.13	Stop ($\overline{\text{STOP}}$)	2-17
2.2.1.13.1	Stop ($\overline{\text{STOP}}$)—Output	2-17
2.2.1.13.2	Stop ($\overline{\text{STOP}}$)—Input	2-17
2.2.1.14	Interrupt Request ($\overline{\text{INTA}}$)—Output	2-17
2.2.1.15	ID Select (IDSEL)—Input	2-17
2.2.2	Memory Interface Signals	2-18
2.2.2.1	SDRAM Command Select ($\overline{\text{CS}}$[0:7])—Output	2-18
2.2.2.2	SDRAM Data Input/Output Mask (DQM[0:7])—Output	2-18
2.2.2.3	Write Enable ($\overline{\text{WE}}$)—Output	2-19
2.2.2.4	SDRAM Address (SDMA[11:0])—Output	2-19
2.2.2.5	SDRAM Address 12 (SDMA12)—Output	2-19
2.2.2.6	SDRAM Address 13 (SDMA13)—Output	2-20
2.2.2.7	SDRAM Address 14 (SDMA14)—Output	2-20
2.2.2.8	SDRAM Internal Bank Select 0–1 (SDBA0, SDBA1)—Output	2-20
2.2.2.9	Memory Data Bus (MDH[0:31], MDL[0:31])	2-21
2.2.2.9.1	Memory Data Bus (MDH[0:31], MDL[0:31])—Output	2-21
2.2.2.9.2	Memory Data Bus (MDH[0:31], MDL[0:31])—Input	2-22
2.2.2.10	Data Parity/ECC (PAR[0:7])	2-22
2.2.2.10.1	Data Parity (PAR[0:7])—Output	2-22
2.2.2.10.2	Data Parity (PAR[0:7])—Input	2-22
2.2.2.11	ROM Address 19:12 (AR[19:12])—Output	2-22
2.2.2.12	SDRAM Clock Enable (CKE)—Output	2-23
2.2.2.13	SDRAM Row Address Strobe ($\overline{\text{SDRAS}}$)—Output	2-23
2.2.2.14	SDRAM Column Address Strobe ($\overline{\text{SDCAS}}$)—Output	2-23
2.2.2.15	ROM Bank Selects ($\overline{\text{RCS}}$[0:3])—Output	2-24

Contents

Paragraph Number	Title	Page Number
2.2.2.16	Flash Output Enable ($\overline{\text{FOE}}$)—Output	2-24
2.2.2.17	Address Strobe ($\overline{\text{AS}}$)—Output	2-24
2.2.2.18	ROM/Port X Data Ready ($\overline{\text{DRDY}}$)—Input	2-25
2.2.3	PIC Control Signals	2-25
2.2.3.1	Discrete Interrupt 0–4 (IRQ[0:4])—Input	2-25
2.2.3.2	Serial Interrupt Mode Signals	2-25
2.2.3.2.1	Serial Interrupt Stream (S_INT)—Input	2-26
2.2.3.2.2	Serial Interrupt Clock (S_CLK)—Output	2-26
2.2.3.2.3	Serial Interrupt Reset (S_RST)—Output	2-26
2.2.3.2.4	Serial Interrupt Frame ($\overline{\text{S_FRAME}}$)—Output	2-26
2.2.3.3	Local Interrupt ($\overline{\text{L_INT}}$)—Output	2-26
2.2.4	I^2C Interface Control Signals	2-26
2.2.4.1	Serial Data (SDA)	2-27
2.2.4.1.1	Serial Data (SDA)—Output	2-27
2.2.4.1.2	Serial Data (SDA)—Input	2-27
2.2.4.2	Serial Clock (SCL)	2-27
2.2.4.2.1	Serial Clock (SCL)—Output	2-27
2.2.4.2.2	Serial Clock (SCL)—Input	2-27
2.2.5	DUART Signals	2-27
2.2.5.1	DUART Serial In Data (SIN1, SIN2)—Input	2-28
2.2.5.2	DUART Serial Out Data (SOUT1, SOUT2)—Output	2-28
2.2.5.3	Clear to Send ($\overline{\text{CTS1}}$)—Input	2-28
2.2.5.4	Receive to Send ($\overline{\text{RTS1}}$)—Output	2-28
2.2.6	System Control and Power Management Signals	2-28
2.2.6.1	Hard Reset	2-29
2.2.6.1.1	Hard Reset (Processor) ($\overline{\text{HRST_CPU}}$)—Input	2-29
2.2.6.1.2	Hard Reset (Peripheral Logic) ($\overline{\text{HRST_CTRL}}$)—Input	2-29
2.2.6.2	Soft Reset ($\overline{\text{SRESET}}$)—Input	2-29
2.2.6.3	Machine Check ($\overline{\text{MCP}}$)—Output	2-30
2.2.6.4	Nonmaskable Interrupt (NMI)—Input	2-31
2.2.6.5	System Management Interrupt ($\overline{\text{SMI}}$)—Input	2-31
2.2.6.6	Checkstop In ($\overline{\text{CHKSTOP_IN}}$)—Input	2-31
2.2.6.7	Time Base Enable (TBEN)—Input	2-32
2.2.6.8	Quiesce Acknowledge ($\overline{\text{QACK}}$)—Output	2-32
2.2.6.9	Watchpoint Trigger Signals	2-32
2.2.6.9.1	Watchpoint Trigger In (TRIG_IN)—Input	2-32
2.2.6.9.2	Watchpoint Trigger Out (TRIG_OUT)—Output	2-33
2.2.6.10	Debug Signals	2-33
2.2.6.10.1	Memory Address Attributes (MAA[0:2])—Output	2-33
2.2.6.10.2	PCI Address Attributes (PMAA[0:2])—Output	2-34
2.2.6.10.3	Debug Address (DA[0:15])—Output	2-34

Contents

Paragraph Number	Title	Page Number
2.2.6.10.4	Memory Interface Valid ($\overline{\text{MIV}}$)—Output	2-34
2.2.7	Test and Configuration Signals	2-35
2.2.7.1	PLL Configuration (PLL_CFG[0:4])—Input	2-35
2.2.7.2	JTAG Test Clock (TCK)—Input	2-35
2.2.7.3	JTAG Test Data Input (TDI)—Input	2-35
2.2.7.4	JTAG Test Data Output (TDO)—Output	2-36
2.2.7.5	JTAG Test Mode Select (TMS)—Input	2-36
2.2.7.6	JTAG Test Reset ($\overline{\text{TRST}}$)—Input	2-36
2.2.8	Clock Signals	2-36
2.2.8.1	System Clock Input (OSC_IN)—Input	2-37
2.2.8.2	PCI Clock (PCI_CLK[0:4])—Output	2-37
2.2.8.3	PCI Clock Synchronize Out (PCI_SYNC_OUT)—Output	2-37
2.2.8.4	PCI Feedback Clock (PCI_SYNC_IN)—Input	2-37
2.2.8.5	SDRAM Clock Outputs (SDRAM_CLK[0:3])—Output	2-37
2.2.8.6	SDRAM Clock Synchronize Out (SDRAM_SYNC_OUT)—Output	2-37
2.2.8.7	SDRAM Feedback Clock (SDRAM_SYNC_IN)—Input	2-38
2.2.8.8	Debug Clock (CKO)—Output	2-38
2.3	Clocking	2-38
2.3.1	Clocking Method	2-38
2.3.2	DLL Operation and Locking	2-40
2.3.3	Clock Synchronization	2-41
2.3.4	Clocking System Solution Examples	2-42
2.4	Configuration Signals Sampled at Reset	2-43

Chapter 3
Address Maps

3.1	Address Map B	3-1
3.2	Address Map B Options	3-6
3.2.1	Processor Compatibility Hole	3-7
3.2.2	PCI Compatibility Hole	3-7
3.2.3	Processor Alias Space	3-7
3.2.4	PCI Alias Space	3-7
3.2.5	Processor Compatibility Hole and Alias Space	3-8
3.2.6	PCI Compatibility Hole and Alias Space	3-10
3.3	Address Translation	3-11
3.3.1	Inbound PCI Address Translation	3-12
3.3.2	Outbound PCI Address Translation	3-16
3.3.3	Outbound PCI Address Translation Using Dual Address Cycles	3-17
3.3.4	Address Translation Registers	3-19
3.3.4.1	Local Memory Base Address Registers (LMBARn)	3-20
3.3.4.2	Inbound Translation Window Registers (ITWRn)	3-21

Contents

Paragraph Number	Title	Page Number
3.3.4.3	Outbound Translation High Base Address Registers (OTHBARn)	3-23
3.3.4.4	Outbound Memory Base Address Registers (OMBARn)	3-23
3.3.4.5	Outbound Translation Window Register (OTWRn)	3-24
3.4	Embedded Utilities Memory Block (EUMB)	3-25
3.4.1	Processor Core Control and Status Registers	3-27
3.4.2	Peripheral Control and Status Registers	3-29

Chapter 4
Configuration Registers

4.1	Configuration Register Access	4-1
4.1.1	Configuration Register Access in Little-Endian Mode	4-2
4.1.2	Configuration Register Access in Big-Endian Mode	4-3
4.1.3	Configuration Register Summary	4-3
4.1.3.1	Processor-Accessible Configuration Registers	4-4
4.1.3.2	PCI-Accessible Configuration Registers	4-8
4.2	PCI Interface Configuration Registers	4-9
4.2.1	PCI Command Register—Offset 0x04	4-10
4.2.2	PCI Status Register—Offset 0x06	4-12
4.2.3	Programming Interface—Offset 0x09	4-13
4.2.4	PCI Base Class Code—Offset 0x0B	4-14
4.2.5	PCI Cache Line Size—Offset 0x0C	4-14
4.2.6	Latency Timer—Offset 0x0D	4-14
4.2.7	PCI Base Address Registers—LMBARn and PCSRBAR	4-14
4.2.8	Subsystem Vendor ID—Offset 0x2C	4-15
4.2.9	Subsystem ID—Offset 0x2E	4-16
4.2.10	PCI Interrupt Line—Offset 0x3C	4-16
4.2.11	PCI General Control Register (PGCR)—Offset 0x44	4-16
4.2.12	PCI Arbiter Control Register (PACR)—Offset 0x46	4-17
4.3	Peripheral Logic Power Management Configuration Registers (PMCRs)	4-18
4.3.1	Power Management Configuration Register 1 (PMCR1)—Offset 0x70	4-18
4.3.2	Power Management Configuration Register 2 (PMCR2)—Offset 0x72	4-20
4.4	Output/Clock Driver and Miscellaneous I/O Control Registers	4-21
4.5	Embedded Utilities Memory Block Base Address Register—0x78	4-25
4.6	Memory Interface Configuration Registers	4-25
4.6.1	Memory Boundary Registers	4-25
4.6.2	Memory Bank Enable Register—0xA0	4-29
4.6.3	Memory Page Mode Register—0xA3	4-30
4.7	Processor Interface Configuration Registers	4-31
4.8	Error Handling Registers	4-35
4.8.1	ECC Single-Bit Error Registers	4-35
4.8.2	Error Enabling and Detection Registers	4-36

Contents

Paragraph Number	Title	Page Number
4.9	Extended ROM Configuration Registers—0xD0, 0xD4, 0xD8, 0xDC	4-42
4.10	Address Map B Options Register—0xE0	4-50
4.11	PCI/Memory Buffer Configuration Register—0xE1	4-51
4.12	PLL Configuration Register—0xE2	4-52
4.13	Register—0xE3	4-53
4.14	Memory Control Configuration Registers	4-53

Chapter 5
G2 Processor Core

5.1	Overview	5-1
5.1.1	Execution Units	5-3
5.1.2	Data Types	5-3
5.1.3	Memory Management	5-3
5.1.4	Bus Operation	5-4
5.2	G2 Processor Core Features	5-4
5.2.1	Instruction Unit	5-5
5.2.2	Instruction Queue and Dispatch Unit	5-6
5.2.3	Branch Processing Unit (BPU)	5-6
5.2.4	Independent Execution Units	5-7
5.2.4.1	Integer Unit (IU)	5-7
5.2.4.2	Floating-Point Unit (FPU)	5-7
5.2.4.3	Load/Store Unit (LSU)	5-7
5.2.4.4	System Register Unit (SRU)	5-8
5.2.5	Completion Unit	5-8
5.2.6	Memory Subsystem Support	5-8
5.2.6.1	Memory Management Units (MMUs)	5-9
5.2.6.2	Cache Units	5-9
5.2.6.3	Peripheral Logic Bus Interface	5-9
5.2.6.3.1	Peripheral Logic Bus Protocol	5-10
5.2.6.3.2	Peripheral Logic Bus Data Transfers	5-10
5.2.6.3.3	Peripheral Logic Bus Frequency	5-11
5.3	Programming Model	5-11
5.3.1	Register Set	5-11
5.3.1.1	PowerPC Register Set	5-12
5.3.1.2	MPC8245-Specific Registers	5-12
5.3.1.2.1	Hardware Implementation-Dependent Register 0 (HID0)	5-14
5.3.1.2.2	Hardware Implementation-Dependent Register 1 (HID1)	5-18
5.3.1.2.3	Hardware Implementation-Dependent Register 2 (HID2)	5-18
5.3.1.2.4	Processor Version Register (PVR)	5-19
5.3.2	PowerPC Instruction Set and Addressing Modes	5-19
5.3.2.1	Calculating Effective Addresses	5-19

Contents

Paragraph Number	Title	Page Number
5.3.2.2	PowerPC Instruction Set	5-19
5.3.2.3	MPC8245 Implementation-Specific Instruction Set	5-21
5.4	Cache Implementation	5-22
5.4.1	PowerPC Cache Model	5-22
5.4.2	MPC8245 Implementation-Specific Cache Implementation	5-22
5.4.2.1	Data Cache	5-23
5.4.2.2	Instruction Cache	5-24
5.4.2.3	Cache Locking	5-24
5.4.2.3.1	Entire Cache Locking	5-25
5.4.2.3.2	Way Locking	5-25
5.4.3	Cache Coherency	5-25
5.4.3.1	CCU Responses to Processor Transactions	5-26
5.4.3.2	Processor Responses to PCI-to-Memory Transactions	5-27
5.5	Exception Model	5-28
5.5.1	PowerPC Exception Model	5-28
5.5.1.1	Exceptions and Exception Handlers	5-28
5.5.2	MPC8245 Implementation-Specific Exception Model	5-29
5.5.3	Exception Priorities	5-32
5.6	Memory Management	5-32
5.6.1	PowerPC MMU Model	5-32
5.6.2	MPC8245 Implementation-Specific MMU Features	5-34
5.7	Instruction Timing	5-35
5.7.1	Stages of the Instruction Pipeline Processor	5-35
5.7.1.1	Fetch Pipeline Stage	5-35
5.7.1.2	Dispatch Pipeline Stage	5-35
5.7.1.3	Execute Pipeline Stage	5-35
5.7.1.4	Complete/Writeback Pipeline Stage	5-36
5.8	Differences Between the MPC8245 Core and the MPC603e Processor	5-36

Chapter 6
Memory Interface

6.1	Memory Interface Signal Summary	6-3
6.2	SDRAM Interface Operation	6-6
6.2.1	Supported SDRAM Organizations	6-9
6.2.2	SDRAM Address Multiplexing	6-11
6.2.3	SDRAM Memory Data Interface	6-15
6.2.4	SDRAM Power-On Initialization	6-17
6.2.5	MPC8245 Interface Functionality for JEDEC SDRAMs	6-19
6.2.6	SDRAM Burst and Single-Beat Transactions	6-20
6.2.7	SDRAM Page Mode	6-21
6.2.7.1	SDRAM Paging in Sleep Mode	6-23

Contents

Paragraph Number	Title	Page Number
6.2.8	SDRAM Interface Timing	6-23
6.2.8.1	SDRAM Mode-Set Command Timing	6-28
6.2.9	SDRAM Parity and RMW Parity	6-28
6.2.9.1	RMW Parity Latency Considerations	6-29
6.2.10	SDRAM In-Line ECC	6-29
6.2.11	SDRAM Registered DIMM Mode	6-31
6.2.12	SDRAM Refresh	6-33
6.2.12.1	SDRAM Refresh Timing	6-35
6.2.12.2	SDRAM Refresh and Power-Saving Modes	6-36
6.2.13	Processor-to-SDRAM Transaction Examples	6-39
6.2.14	PCI-to-SDRAM Transaction Examples	6-45
6.3	ROM/Flash Interface Operation	6-49
6.3.1	Base ROM Interface Operation	6-51
6.3.1.1	Base ROM Address Multiplexing	6-53
6.3.2	Extended ROM Interface	6-55
6.3.2.1	Extended ROM Address Multiplexing	6-57
6.3.2.2	Extended ROM Interface Read Gathering	6-59
6.3.3	ROM/Flash Interface Write Operations	6-60
6.3.4	ROM Interface Timing	6-60
6.3.4.1	Read Timing—64-/32-Bit (Wide) Data Path	6-62
6.3.4.2	Read Timing—8-Bit Data Path	6-64
6.3.4.3	ROM/Flash Interface Write Timing	6-66
6.3.5	Port X Interface	6-66
6.3.5.1	Port X Operation	6-68
6.3.5.2	Port X Timing	6-69
6.3.5.3	Port X Strobe Mode	6-71
6.3.5.4	Port X Handshake Mode	6-71
6.3.6	PCI-to-ROM/Port X Transaction Example	6-73

Chapter 7
PCI Bus Interface

7.1	PCI Interface Overview	7-1
7.1.1	MPC8245 as a PCI Initiator	7-2
7.1.2	MPC8245 as a PCI Target	7-3
7.1.3	PCI Signal Output Hold Timing	7-3
7.1.4	PCI 2.2-Compatible Extensions to MPC8240 and the Tundra Tsi107™ PowerPC Host Bridge	7-4
7.2	PCI Bus Arbitration	7-4
7.2.1	Internal Arbitration for PCI Bus Access	7-5
7.2.1.1	Processor-Initiated Transactions to PCI Bus	7-6
7.2.1.2	DMA-Initiated Transactions to the PCI Bus	7-6

Contents

Paragraph Number	Title	Page Number
7.2.2	PCI Bus Arbiter Operation	7-6
7.2.3	PCI Bus Parking	7-8
7.2.4	Power-Saving Modes and the PCI Arbiter	7-8
7.2.5	Broken Master Lock-Out	7-9
7.3	MPC8245 PCI Bus Protocol	7-9
7.3.1	Basic Transfer Control	7-9
7.3.2	PCI Bus Commands	7-10
7.3.3	Addressing	7-12
7.3.3.1	Memory Space Addressing	7-12
7.3.3.2	I/O Space Addressing	7-13
7.3.3.3	Configuration Space Addressing	7-13
7.3.4	Device Selection	7-13
7.3.5	Byte Alignment	7-14
7.3.6	Bus Driving and Turnaround	7-14
7.4	PCI Bus Transactions	7-15
7.4.1	PCI Read Transactions	7-15
7.4.2	PCI Write Transactions	7-17
7.4.3	Transaction Termination	7-18
7.4.3.1	Master-Initiated Termination	7-18
7.4.3.2	Target-Initiated Termination	7-18
7.4.3.2.1	Target-Disconnect Termination	7-19
7.4.3.2.2	Retry Termination	7-20
7.4.3.2.3	Target-Abort Termination	7-20
7.4.4	Fast Back-to-Back Transactions	7-21
7.4.5	Dual Address Cycles (Master-Only)	7-23
7.4.6	Configuration Cycles	7-25
7.4.6.1	PCI Configuration Space Header	7-25
7.4.6.2	Accessing the PCI Configuration Space	7-27
7.4.6.2.1	Type 0 Configuration Translation	7-28
7.4.6.2.2	Type 1 Configuration Translation	7-30
7.4.7	Other Bus Transactions	7-30
7.4.7.1	Interrupt-Acknowledge Transactions	7-30
7.4.7.2	Special-Cycle Transactions	7-31
7.5	Exclusive Access	7-32
7.5.1	Starting an Exclusive Access	7-32
7.5.2	Continuing an Exclusive Access	7-33
7.5.3	Completing an Exclusive Access	7-33
7.5.4	Attempting to Access a Locked Target	7-33
7.5.5	Exclusive Access and the MPC8245	7-33
7.6	PCI Error Functions	7-34
7.6.1	PCI Parity	7-34

Contents

Paragraph Number	Title	Page Number
7.6.2	Error Reporting	7-35
7.7	PCI Host and Agent Modes	7-35
7.7.1	PCI Initialization Options	7-36
7.7.2	Accessing the MPC8245 Configuration Space	7-36
7.7.3	PCI Configuration Cycle Retry Capability in Agent Mode	7-37
7.7.4	PCI Address Translation Support	7-37
7.7.4.1	Inbound PCI Address Translation	7-37
7.7.4.2	Outbound PCI Address Translation	7-38
7.7.4.3	Initialization Code Translation in Agent Mode	7-38

Chapter 8
DMA Controller

8.1	DMA Overview	8-1
8.2	DMA Register Summary	8-2
8.3	DMA Operation	8-4
8.3.1	DMA Direct Mode	8-5
8.3.2	DMA Chaining Mode	8-6
8.3.2.1	Basic Chaining Mode Initialization	8-6
8.3.2.2	Periodic DMA Feature	8-6
8.3.3	DMA Operation Flow	8-8
8.3.4	DMA Coherency	8-9
8.3.5	DMA Performance	8-9
8.4	DMA Transfer Types	8-10
8.4.1	PCI-to-PCI	8-10
8.4.2	PCI-to-Local Memory	8-10
8.4.3	Local Memory-to-PCI	8-10
8.4.4	Local Memory to Local Memory	8-11
8.5	Address Map Interactions	8-11
8.5.1	Attempted Writes to Local ROM/Port X Space	8-11
8.5.2	Host Mode Interactions	8-11
8.5.2.1	PCI Master Abort When PCI Bus Specified for Lower 2-Gbyte Space	8-12
8.5.2.2	Address Alias to Lower 2-Gbyte Space	8-12
8.5.2.3	Attempted Reads From ROM on the PCI Bus—Host Mode	8-12
8.5.2.4	Attempted Reads From ROM on the Memory Bus	8-12
8.5.2.5	Address Translations for PCI Transactions	8-12
8.5.3	Agent Mode Interactions	8-12
8.5.3.1	Agent Mode DMA Transfers for PCI	8-13
8.5.3.2	Accesses to Outbound Memory Window that Overlaps 0xFE00_0000 – 0xFEEF_FFFF	8-13
8.5.3.3	Attempted Accesses to Local ROM When ROM is on PCI	8-13
8.5.3.4	Attempted Access to ROM on the PCI Bus—Agent Mode	8-13

Contents

Paragraph Number	Title	Page Number
8.6	DMA Descriptors for Chaining Mode	8-14
8.6.1	Descriptors in Big-Endian Mode	8-16
8.6.2	Descriptors in Little-Endian Mode	8-17
8.7	DMA Register Descriptions	8-18
8.7.1	DMA Mode Registers (DMRs)	8-18
8.7.2	DMA Status Registers (DSRs)	8-21
8.7.3	Current Descriptor Address Registers (CDARs)	8-23
8.7.4	High Current Descriptor Address Registers (HCDARs)	8-24
8.7.5	Source Address Registers (SARs)	8-25
8.7.6	High Source Address Registers (HSARs)	8-26
8.7.7	Destination Address Registers (DARs)	8-26
8.7.8	High Destination Address Registers (HDARs)	8-27
8.7.9	Byte Count Registers (BCRs)	8-27
8.7.10	Next Descriptor Address Registers (NDARs)	8-28
8.7.11	High Next Descriptor Address Registers (HNDARs)	8-29

Chapter 9
Message Unit (with I_2O)

9.1	Message Unit (MU) Overview	9-1
9.2	Message and Doorbell Register Programming Model	9-1
9.2.1	Message and Doorbell Register Summary	9-2
9.2.2	Message Register Descriptions	9-2
9.2.3	Doorbell Register Descriptions	9-3
9.3	I_2O Interface	9-4
9.3.1	PCI Configuration Identification	9-4
9.3.2	I_2O Register Summary	9-5
9.3.3	FIFO Descriptions	9-6
9.3.3.1	Inbound FIFOs	9-7
9.3.3.1.1	Inbound Free_List FIFO	9-7
9.3.3.1.2	Inbound Post_List FIFO	9-7
9.3.3.2	Outbound FIFOs	9-8
9.3.3.2.1	Outbound Free_List FIFO	9-8
9.3.3.2.2	Outbound Post_List FIFO	9-8
9.3.4	I_2O Register Descriptions	9-8
9.3.4.1	PCI-Accessible I_2O Registers	9-9
9.3.4.1.1	Outbound Message Interrupt Status Register (OMISR)	9-9
9.3.4.1.2	Outbound Message Interrupt Mask Register (OMIMR)	9-11
9.3.4.1.3	Inbound FIFO Queue Port Register (IFQPR)	9-12
9.3.4.1.4	Outbound FIFO Queue Port Register (OFQPR)	9-13
9.3.4.2	Processor-Accessible I_2O Registers	9-13
9.3.4.2.1	Inbound Message Interrupt Status Register (IMISR)	9-13

Contents

Paragraph Number	Title	Page Number
9.3.4.2.2	Inbound Message Interrupt Mask Register (IMIMR)	9-16
9.3.4.2.3	Inbound Free_FIFO Head Pointer Register (IFHPR)	9-17
9.3.4.2.4	Inbound Free_FIFO Tail Pointer Register (IFTPR)	9-17
9.3.4.2.5	Inbound Post_FIFO Head Pointer Register (IPHPR)	9-18
9.3.4.2.6	Inbound Post_FIFO Tail Pointer Register (IPTPR)	9-19
9.3.4.2.7	Outbound Free_FIFO Head Pointer Register (OFHPR)	9-19
9.3.4.2.8	Outbound Free_FIFO Tail Pointer Register (OFTPR)	9-20
9.3.4.2.9	Outbound Post_FIFO Head Pointer Register (OPHPR)	9-21
9.3.4.2.10	Outbound Post_FIFO Tail Pointer Register (OPTPR)	9-21
9.3.4.2.11	Messaging Unit Control Register (MUCR)	9-22
9.3.4.2.12	Queue Base Address Register (QBAR)	9-23

Chapter 10
I^2C Interface

10.1	I^2C Interface Overview	10-1
10.1.1	I^2C Unit Features	10-1
10.1.2	I^2C Interface Signal Summary	10-2
10.1.3	I^2C Register Summary	10-2
10.1.4	I^2C Block Diagram	10-3
10.2	I^2C Protocol	10-4
10.2.1	START Condition	10-4
10.2.2	Slave Address Transmission	10-4
10.2.3	Repeated START Condition	10-5
10.2.4	STOP Condition	10-6
10.2.5	Arbitration Procedure	10-6
10.2.6	Clock Synchronization	10-7
10.2.7	Handshaking	10-7
10.2.8	Clock Stretching	10-7
10.3	I^2C Register Descriptions	10-7
10.3.1	I^2C Address Register (I2CADR)	10-8
10.3.2	I^2C Frequency Divider Register (I2CFDR)	10-8
10.3.3	I^2C Control Register (I2CCR)	10-11
10.3.4	I^2C Status Register (I2CSR)	10-13
10.3.5	I^2C Data Register (I2CDR)	10-14
10.4	Programming Guidelines	10-15
10.4.1	Initialization Sequence	10-15
10.4.2	Generation of START	10-16
10.4.3	Post-Transfer Software Response	10-16
10.4.4	Generation of STOP	10-17
10.4.5	Generation of Repeated START	10-17
10.4.6	Generation of SCK when SDA Low	10-17

Contents

Paragraph Number	Title	Page Number
10.4.7	Slave Mode Interrupt Service Routine	10-18
10.4.7.1	Slave Transmitter and Received Acknowledge	10-18
10.4.7.2	Loss of Arbitration and Forcing of Slave Mode	10-18
10.4.8	Interrupt Service Routine Flowchart	10-18

Chapter 11
Programmable Interrupt Controller (PIC) Unit

11.1	PIC Unit Overview	11-1
11.1.1	PIC Features Summary	11-2
11.1.2	PIC Interface Signal Description	11-2
11.1.3	PIC Block Diagram	11-3
11.2	PIC Register Summary	11-3
11.3	PIC Unit Interrupt Protocol	11-7
11.3.1	Interrupt Source Priority	11-7
11.3.2	Processor Current Task Priority	11-8
11.3.3	Interrupt Acknowledge	11-8
11.3.4	Nesting of Interrupts	11-8
11.3.5	Spurious Vector Generation	11-8
11.3.6	Internal Block Diagram Description	11-9
11.3.6.1	Interrupt Pending Register (IPR)—Nonprogrammable	11-9
11.3.6.2	Interrupt Selector (IS)	11-10
11.3.6.3	Interrupt Request Register (IRR)	11-10
11.3.6.4	In-Service Register (ISR)	11-10
11.4	PIC Pass-Through Mode	11-10
11.5	PIC Direct Interrupt Mode	11-11
11.6	PIC Serial Interrupt Interface	11-11
11.6.1	Sampling of Serial Interrupts	11-11
11.6.2	Serial Interrupt Timing Protocol	11-12
11.6.3	Edge/Level Sensitivity of Serial Interrupts	11-12
11.7	PIC Timers	11-12
11.8	Programming Guidelines	11-13
11.8.1	Edge-Sensitive False Interrupts	11-15
11.8.2	Global Timer False Interrupts	11-15
11.9	Register Definitions	11-15
11.9.1	Feature Reporting Register (FRR)	11-15
11.9.2	Global Configuration Register (GCR)	11-16
11.9.3	PIC Interrupt Configuration Register (ICR)	11-17
11.9.4	PIC Vendor Identification Register (EVI)	11-18
11.9.5	Processor Initialization Register (PI)	11-19
11.9.6	Spurious Vector Register (SVR)	11-19
11.9.7	Global Timer Registers	11-20

Contents

Paragraph Number	Title	Page Number
11.9.7.1	Timer Frequency Reporting Register (TFRR)	11-20
11.9.7.2	Timer Control Register (TCR)	11-21
11.9.7.3	Global Timer Current Count Registers (GTCCRn)	11-22
11.9.7.4	Global Timer Base Count Registers (GTBCRn)	11-22
11.9.7.5	Global Timer Vector/Priority Registers (GTVPRs)	11-23
11.9.7.6	Global Timer Destination Registers (GTDRs)	11-24
11.9.8	External (Direct and Serial) and Internal Interrupt Registers	11-25
11.9.8.1	Direct and Serial Interrupt Vector/Priority Registers (IVPRs, SVPRs)	11-25
11.9.8.2	Direct and Serial Interrupt Destination Registers (IDRs and SIRs)	11-26
11.9.8.3	Internal (I^2C, DMA, MU, DUART) Interrupt Vector/Priority Registers (IIVPRs)	11-27
11.9.8.4	Internal (I^2C, DMA, MU, or DUART) Interrupt Destination Registers (IIDRs)	11-28
11.9.9	Processor-Related Registers	11-28
11.9.9.1	Processor Current Task Priority Register (PCTPR)	11-28
11.9.9.2	Processor Interrupt Acknowledge Register (IACK)	11-29
11.9.10	Processor End-of-Interrupt Register (EOI)	11-29

Chapter 12
DUART Unit

12.1	DUART Overview	12-1
12.1.1	DUART Unit Features	12-1
12.1.2	DUART Block Diagram	12-2
12.1.3	DUART Signal Description	12-3
12.1.4	DUART Signal Mode Selection	12-4
12.1.5	DUART Register Summary	12-5
12.2	DUART Operation	12-8
12.2.1	Serial Interface	12-8
12.2.1.1	START Bit	12-9
12.2.1.2	Data Transfer	12-9
12.2.1.3	Parity Bit	12-10
12.2.1.4	STOP Bit	12-10
12.2.2	Baud-Rate Generator Logic	12-10
12.2.3	Local Loop Back Mode	12-10
12.2.4	Errors	12-11
12.2.4.1	Framing Error	12-11
12.2.4.2	Parity Error	12-11
12.2.4.3	Overrun Error	12-11
12.2.5	FIFO Mode	12-12
12.2.5.1	FIFO Interrupts	12-12

Contents

Paragraph Number	Title	Page Number
12.2.5.2	DMA Mode Select	12-12
12.2.6	Interrupt Control Logic	12-13
12.3	DUART Initialization Sequence	12-13
12.4	Programming Model	12-14
12.4.1	Receiver Buffer Register (URBR)	12-14
12.4.2	Divisor Most and Least Significant Byte Registers (UDMB and UDLB)	12-15
12.4.3	Transmitter Holding Register (UTHR)	12-16
12.4.4	Interrupt Enable Register (UIER)	12-16
12.4.5	Interrupt ID Register (UIIR)	12-17
12.4.6	FIFO Control Register (UFCR)	12-19
12.4.7	Line Control Register (ULCR)	12-20
12.4.8	MODEM Control Register (UMCR)	12-22
12.4.9	Line Status Register (ULSR)	12-23
12.4.10	MODEM Status Register (UMSR)	12-24
12.4.11	Scratch Register (USCR)	12-25
12.4.12	Alternate Function Register (UAFR)	12-25
12.4.13	DMA Status Register (UDSR)	12-26
12.4.14	DUART Configuration Register (DCR)	12-28

Chapter 13
Central Control Unit

13.1	Internal Buffers	13-1
13.1.1	Processor Core/Local Memory Buffers	13-2
13.1.2	Processor/PCI Buffers	13-3
13.1.2.1	Processor-to-PCI-Read Buffer (PRPRB)	13-4
13.1.2.2	Processor-to-PCI-Write Buffers (PRPWBs)	13-5
13.1.3	PCI/Local Memory Buffers	13-6
13.1.3.1	PCI-to-Local-Memory Read Buffering	13-7
13.1.3.1.1	PCI-to-Local-Memory Read Buffers (PCMRBs)	13-7
13.1.3.1.2	Speculative PCI Reads from Local Memory	13-8
13.1.3.2	PCI-to-Local-Memory-Write Buffers (PCMWBs)	13-8
13.2	Internal Arbitration	13-9
13.2.1	Arbitration Between PCI and DMA Accesses to Local Memory	13-9
13.2.1.1	DMA Transaction Boundaries for Memory/Memory Transfers	13-10
13.2.1.2	DMA Transaction Boundaries for Memory-to-PCI Transfers	13-11
13.2.1.3	DMA Transaction Boundaries for PCI—Memory Transfers	13-11
13.2.1.4	PCI and DMA Reads from Slow Memory/Port X	13-11
13.2.2	Internal Arbitration Priorities	13-12
13.2.3	Guaranteeing Minimum PCI Access Latency to Local Memory	13-13

Contents

Paragraph Number	Title	Page Number
	Chapter 14 Error Handling	
14.1	Overview	14-1
14.1.1	Error Handling Block Diagram	14-2
14.1.2	Priority of Externally Generated Errors and Exceptions	14-3
14.2	Exceptions and Error Signals	14-3
14.2.1	System Reset	14-3
14.2.2	Processor Core Error Signal (*mcp*)	14-4
14.2.3	PCI Bus Error Signals	14-5
14.2.3.1	System Error (SERR)	14-5
14.2.3.2	Parity Error (PERR)	14-5
14.2.3.3	Nonmaskable Interrupt (NMI)	14-6
14.3	Error Reporting	14-6
14.3.1	Processor Interface Errors	14-7
14.3.1.1	Processor Transaction Error	14-7
14.3.1.2	Flash Write Error	14-8
14.3.1.3	Processor Write Parity Error	14-8
14.3.2	Memory Interface Errors	14-8
14.3.2.1	Memory Read Data Parity Error	14-9
14.3.2.2	Memory ECC Error	14-9
14.3.2.3	Memory Select Error	14-10
14.3.2.4	Memory Refresh Overflow Error	14-10
14.3.3	PCI Interface Errors	14-10
14.3.3.1	PCI Address Parity Error	14-10
14.3.3.2	PCI Data Parity Error	14-11
14.3.3.3	PCI Master-Abort Transaction Termination	14-11
14.3.3.4	Received PCI Target-Abort Error	14-12
14.3.3.5	NMI (Nonmaskable Interrupt)	14-12
14.3.4	Message Unit Error Events	14-12
14.4	Exception Latencies	14-13
	Chapter 15 Power Management	
15.1	Overview	15-1
15.2	Processor Core Power Management	15-1
15.2.1	Dynamic Power Management	15-2
15.2.2	Programmable Power Modes on Processor Core	15-2
15.2.3	Processor Power Management Modes—Details	15-4
15.2.3.1	Full-Power Mode with DPM Disabled	15-4
15.2.3.2	Full-Power Mode with DPM Enabled	15-4

Contents

Paragraph Number	Title	Page Number
15.2.3.3	Processor Doze Mode	15-5
15.2.3.4	Processor Nap Mode	15-5
15.2.3.5	Processor Sleep Mode	15-6
15.2.4	Power Management Software Considerations	15-7
15.3	Peripheral Logic Power Management	15-7
15.3.1	MPC8245 Peripheral Power Mode Transitions	15-8
15.3.2	Peripheral Power Management Modes	15-9
15.3.2.1	Peripheral Logic Full-Power Mode	15-9
15.3.2.2	Peripheral Logic Doze Mode	15-9
15.3.2.3	Peripheral Logic Nap Mode	15-10
15.3.2.3.1	PCI Transactions During Nap Mode	15-11
15.3.2.3.2	PLL Operation During Nap Mode	15-11
15.3.2.4	Peripheral Logic Sleep Mode	15-11
15.3.2.4.1	System Memory Refresh During Sleep Mode	15-12
15.3.2.4.2	Disabling the PLL During Sleep Mode	15-12
15.3.2.4.3	SDRAM Paging During Sleep Mode	15-12
15.4	Disabling Peripheral Clocks	15-12
15.5	Example Code Sequence for Processor and Peripheral Logic Sleep Modes	15-13

Chapter 16
Performance Monitor

16.1	Overview	16-1
16.2	Performance Monitor Registers	16-1
16.2.1	Command Registers (CMDR[0:3])	16-2
16.2.2	Monitor Mode Control Register (MMCR)	16-3
16.2.3	Performance Monitor Counter (PMC0–PMC3)	16-4
16.3	Event Selection	16-5
16.3.1	Command Type 0 Events	16-7
16.3.2	Command Type 1 Events	16-8
16.3.3	Threshold Events	16-14
16.3.4	Burstiness	16-15
16.4	Performance Monitor Examples	16-16
16.4.1	Determining UART Baud Rate	16-16
16.4.1.1	Measuring the UART Baud Rate Error	16-17
16.4.2	Interrupt Latency	16-18
16.4.3	PCI Performance	16-20
16.4.3.1	PCI Utilization	16-20
16.4.3.2	PCI Efficiency	16-21
16.4.3.3	PCI Throughput	16-22
16.4.4	DMA Performance	16-23
16.4.4.1	DMA Channel Busy	16-23

Contents

Paragraph Number	Title	Page Number
16.4.4.2	DMA Segment Busy	16-24

Chapter 17
Debug Features

17.1	Debug Register Summary	17-1
17.2	Address Attribute Signals	17-2
17.2.1	Memory Address Attribute Signals (MAA[0:2])	17-2
17.2.2	Memory Address Attribute Signal Timing	17-3
17.2.3	PCI Address Attribute Signals	17-3
17.2.4	PCI Address Attribute Signal Timing	17-5
17.3	Memory Debug Address	17-6
17.3.1	Enabling Debug Address	17-6
17.3.2	Debug Address Signal Definitions	17-6
17.3.3	Physical Address Mappings	17-7
17.3.4	CS Encoding	17-8
17.3.5	Extended ROM Chip Select Encoding	17-9
17.3.6	Debug Address Timing	17-10
17.4	Memory Interface Valid (MIV)	17-10
17.4.1	$\overline{\text{MIV}}$ Signal Timing	17-11
17.5	Memory Datapath Error Injection/Capture	17-15
17.5.1	Memory Data-Path Error Injection Mask Registers	17-16
17.5.1.1	Data High Error Injection Mask Register	17-16
17.5.1.2	Data Low Error Injection Mask Register	17-17
17.5.1.3	Parity Error Injection Mask Register	17-17
17.5.2	Memory Data-Path Error Capture Monitor Registers	17-18
17.5.2.1	Data High Error Capture Monitor Register	17-18
17.5.2.2	Data Low Error Capture Monitor Register	17-18
17.5.2.3	Parity Error Capture Monitor Register	17-19
17.6	JTAG/Testing Support	17-19
17.6.1	JTAG Signals	17-20
17.6.2	JTAG Registers and Scan Chains	17-21
17.6.2.1	Bypass Register	17-21
17.6.2.2	Boundary-Scan Registers	17-21
17.6.2.3	Instruction Register	17-21
17.6.2.4	TAP Controller	17-21

Chapter 18
Programmable I/O and Watchpoint

18.1	Overview	18-1
18.2	Watchpoint Interface Signal Description	18-2

Contents

Paragraph Number	Title	Page Number
18.3	Watchpoint Registers	18-3
18.3.1	Watchpoint Register Address Map	18-3
18.3.2	Watchpoint Trigger Registers	18-4
18.3.3	Watchpoint Mask Registers	18-7
18.3.4	Watchpoint Control Register (WP_CONTROL)	18-9
18.4	State and Block Diagrams	18-14
18.5	Watchpoint Trigger Applications	18-15

Appendix A
Bit and Byte Ordering

A.1	Byte Ordering Overview	A-1
A.2	Byte Ordering Mechanisms	A-1
A.3	Big-Endian Mode	A-2
A.4	Little-Endian Mode	A-6
A.4.1	I/O Addressing in Little-Endian Mode	A-15
A.5	Setting the Endian Mode of Operation	A-15

Appendix B
Initialization Example

Appendix C
PowerPC Instruction Set Listings

C.1	Instructions Sorted by Mnemonic	C-1
C.2	Instructions Sorted by Opcode	C-9
C.3	Instructions Grouped by Functional Categories	C-17
C.4	Instructions Sorted by Form	C-27
C.5	Instruction Set Legend	C-39

Appendix D
Processor Core Register Summary

D.1	PowerPC Register Set	D-1
D.1.1	PowerPC Register Set—UISA	D-2
D.1.1.1	General-Purpose Registers (GPRs)	D-4
D.1.1.2	Floating-Point Registers (FPRs)	D-4
D.1.1.3	Condition Register (CR)	D-4
D.1.1.3.1	Condition Register CR0 Field Definition	D-5
D.1.1.3.2	Condition Register CR1 Field Definition	D-5
D.1.1.3.3	Condition Register CR*n* Field—Compare Instruction	D-5
D.1.1.4	Floating-Point Status and Control Register (FPSCR)	D-6

Contents

Paragraph Number	Title	Page Number
D.1.1.5	XER Register (XER)	D-8
D.1.1.6	Link Register (LR)	D-9
D.1.1.7	Count Register (CTR)	D-9
D.1.2	PowerPC VEA Register Set—Time Base	D-10
D.1.2.1	Reading the Time Base	D-11
D.1.2.2	Computing Time of Day from the Time Base	D-11
D.1.3	PowerPC OEA Register Set	D-12
D.1.3.1	Machine State Register (MSR)	D-14
D.1.3.2	Processor Version Register (PVR)	D-16
D.1.3.3	BAT Registers	D-16
D.1.3.4	SDR1	D-18
D.1.3.5	Segment Registers	D-18
D.1.3.6	SPRG0–SPRG3	D-19
D.1.3.7	DSISR	D-19
D.1.3.8	Machine Status Save/Restore Register 0 (SRR0)	D-20
D.1.3.9	Time Base Facility (TB)—OEA; Writing to the Time Base	D-20
D.1.3.10	Decrementer Register (DEC)	D-20
D.1.3.11	External Access Register (EAR)	D-21
D.2	Implementation-Specific Registers from MPC603e	D-21
D.2.1	Data and Instruction TLB Miss Address Registers (DMISS and IMISS)	D-22
D.2.2	Data and Instruction TLB Compare Registers (DCMP and ICMP)	D-22
D.2.3	Primary and Secondary Hash Address Registers (HASH1 and HASH2)	D-23
D.2.4	Required Physical Address Register (RPA)	D-23
D.2.5	Instruction Address Breakpoint Register (IABR)	D-24
D.3	MPC8245-Specific Registers	D-24
D.3.1	Hardware Implementation-Dependent Register 0 (HID0)	D-25
D.3.2	Hardware Implementation-Dependent Register 1 (HID1)	D-28
D.3.3	Hardware Implementation-Dependent Register 2 (HID2)	D-29

Appendix E
Revision History

E.1	Revision Changes From Revision 1 to Revision 2	E-1

Glossary of Terms and Abbreviations

Index

Contents

Paragraph Number	Title	Page Number

Figures

Figure Number	Title	Page Number
1-1	MPC8245 Integrated Processor Functional Block Diagram	1-2
1-2	System Using MPC8245 as a Host Processor	1-7
1-3	Embedded System Using an MPC8245 as a Peripheral Processor	1-8
1-4	Embedded System Using an MPC8245 as a Distributed Processor	1-9
1-5	MPC8245 Integrated Processor Core Block Diagram	1-11
1-6	MPC8245 Peripheral Logic Block Diagram	1-15
2-1	MPC8245 Signal Groups	2-3
2-2	Clock Subsystem Block Diagram	2-39
2-3	Timing Diagram (1x, 1.5x, 2x, 2.5x, and 3x examples)	2-39
2-4	System Clocking with External PLL	2-42
2-5	Clocking Solution—Small Load Requirements	2-43
2-6	Clocking Solution—High Clock Fanout Required	2-43
3-1	Processor Address Map B in Host Mode	3-4
3-2	PCI Memory Master Address Map B in Host Mode	3-5
3-3	PCI I/O Master Address Map B	3-6
3-4	Address Map B Processor Options in Host Mode	3-9
3-5	Address Map B PCI Options in Host Mode	3-11
3-6	Inbound PCI Address Translation	3-13
3-7	Many-to-One Mapping	3-14
3-8	One-to-Many Mapping	3-15
3-9	Outbound PCI Address Translation, OTHBAR = 0	3-16
3-10	Outbound Dual Address Cycles, OTHBAR ≠ 0	3-18
3-11	Local Memory Base Address Registers (LMBARn)—Offset 0x10 and 0x18	3-20
3-12	Inbound Translation Window Register (ITWRn)—Offset 0x0_2310 and 0x0_2330	3-21
3-13	Outbound Translation High Base Address Registers (OTHBARn)—Offset 0x0_0230C and 0x0_232C	3-23
3-14	Outbound Memory Base Address Registers (OMBARn)—Offset 0x0_2300 and 0x0_2320	3-24
3-15	Outbound Translation Window Registers (OTWRn)—Offset 0x0_2308 and 0x0_2328	3-24
3-16	Embedded Utilities Memory Block Mapping to Local Memory	3-27
3-17	Embedded Utilities Memory Block Mapping to PCI Memory	3-29
4-1	Processor Accessible Configuration Space	4-7

Figures

Figure Number	Title	Page Number
4-2	PCI Accessible Configuration Space	4-9
4-3	PCI Command Register—0x04	4-11
4-4	PCI Status Register—0x06	4-12
4-5	Power Management Configuration Register 1 (PMCR1)—0x70	4-18
4-6	Power Management Configuration Register 2 (PMCR2)—0x72	4-20
4-7	Memory Starting Address Register 1—0x80	4-26
4-8	Memory Starting Address Register 2—0x84	4-26
4-9	Extended Memory Starting Address Register 1—0x88.	4-26
4-10	Extended Memory Starting Address Register 2—0x8C	4-27
4-11	Memory Ending Address Register 1—0x90	4-27
4-12	Memory Ending Address Register 2—0x94	4-28
4-13	Extended Memory Ending Address Register 1—0x98	4-28
4-14	Extended Memory Ending Address Register 2—0x9C	4-28
4-15	Memory Bank Enable Register—0xA0	4-29
4-16	Memory Page Mode Register—0xA3	4-30
4-17	Processor Interface Configuration Register 1 (PICR1)—0xA8	4-31
4-18	Processor Interface Configuration Register 2 (PICR2)—0xAC	4-33
4-19	ECC Single-Bit Error Counter Register—0xB8	4-35
4-20	ECC Single-Bit Error Trigger Register—0xB9	4-35
4-21	Error Enabling Register 1 (ErrEnR1)—0xC0	4-37
4-22	Error Detection Register 1 (ErrDR1)—0xC1	4-38
4-23	Internal Processor Bus Error Status Register—0xC3	4-39
4-24	Error Enabling Register 2 (ErrEnR2)—0xC4	4-39
4-25	Error Detection Register 2 (ErrDR2)—0xC5	4-40
4-26	PCI Bus Error Status Register—0xC7	4-41
4-27	Processor/PCI Error Address Register—0xC8	4-41
4-28	ERCR1 and ERCR2—0xD0, 0xD4	4-42
4-29	ERCR3 and ERCR4—0xD8, 0xDC	4-49
4-30	Address Map B Options Register (AMBOR)—0xE0	4-50
4-31	PCI/Memory Buffer Configuration Register (PCMBCR)—0xE1	4-51
4-32	PLL Configuration Register (PCR)—0xE2	4-52
4-33	Memory Control Configuration Register 1 (MCCR1)—0xF0	4-53
4-34	Memory Control Configuration Register 2 (MCCR2)—0xF4	4-56
4-35	Memory Control Configuration Register 3 (MCCR3)—0xF8	4-59
4-36	Memory Control Configuration Register 4 (MCCR4)—0xFC	4-60
5-1	MPC8245 Integrated Processor Core Block Diagram	5-2
5-2	MPC8245 Programming Model—Registers	5-13
5-3	Hardware Implementation Register 0 (HID0)	5-14
5-4	Hardware Implementation Register 1 (HID1)	5-18
5-5	Hardware Implementation-Dependent Register 2 (HID2)	5-18
5-6	Data Cache Organization	5-23

Figures

Figure Number	Title	Page Number
6-1	Block Diagram for Memory Interface	6-3
6-2	SDRAM Memory Interface Block Diagram	6-6
6-3	Example 512-MByte SDRAM Configuration With Parity	6-8
6-4	SDRAM Registered Memory Interface	6-16
6-5	SDRAM In-Line ECC/Parity Memory Interface	6-17
6-6	PGMAX Parameter Setting for SDRAM Interface	6-22
6-7	SDRAM Single-Beat Read Timing (SDRAM Burst Length = 4)	6-24
6-8	SDRAM Four-Beat Burst Read Timing Configuration—64-Bit Mode	6-25
6-9	SDRAM Eight-Beat Burst Read Timing Configuration—32-Bit Mode	6-25
6-10	SDRAM Single-Beat Write Timing (SDRAM Burst Length = 4)	6-26
6-11	SDRAM Four-Beat Burst Write Timing—64-Bit Mode	6-26
6-12	SDRAM Eight-Beat Burst Write Timing—32-Bit Mode	6-27
6-13	SDRAM Mode Register Set Timing	6-28
6-14	Registered SDRAM DIMM Single-Beat Write Timing	6-32
6-15	Registered SDRAM DIMM Burst-Write Timing	6-33
6-16	SDRAM Refresh Period	6-33
6-17	SDRAM Bank Staggered CBR Refresh Timing	6-36
6-18	SDRAM Self-Refresh Entry	6-38
6-19	SDRAM Self-Refresh Exit	6-38
6-20	Processor Burst Reads from SDRAM	6-40
6-21	Processor Single-Beat Reads from SDRAM	6-41
6-22	Processor Burst Writes to SDRAM	6-42
6-23	Processor Single-Beat Writes to SDRAM	6-43
6-24	Processor Single-Beat Reads Followed by Writes to SDRAM	6-44
6-25	PCI Reads from SDRAM-Speculative Reads Enabled	6-46
6-26	PCI Reads from SDRAM-Speculative Reads Disabled	6-47
6-27	PCI Writes to SDRAM	6-48
6-28	ROM Memory Interface Block Diagram	6-49
6-29	16-Mbyte ROM System Including Parity Paths to DRAM—64-Bit Mode	6-50
6-30	2-Mbyte Flash Memory System Including Parity Paths to DRAM—8-Bit Mode	6-51
6-31	Base ROM Address Multiplexing—8-Bit Data Path	6-54
6-32	Base ROM Address Multiplexing—32-Bit Data Path	6-54
6-33	Base ROM Address Multiplexing—64-Bit Data Path	6-55
6-34	Extended ROM Address Multiplexing—8-Bit Data Path	6-58
6-35	Extended ROM Address Multiplexing—16-Bit Data Path	6-58
6-36	Extended ROM Address Multiplexing—32-Bit Data Path	6-59
6-37	Extended ROM Address Multiplexing—64-Bit Data Path	6-59
6-38	Read Access Timing for Non-Burst ROM/Flash Devices—64-/32-Bit (Wide) Data Path	6-62
6-39	Read Access Timing (Cache Block) for Burst ROM/Flash Devices—64-Bit (Wide) Data Path	6-63

Figures

Figure Number	Title	Page Number
6-40	Read Access Timing (Cache Block) for Burst ROM/Flash Devices—32-Bit (Wide) Data Path	6-63
6-41	8-Bit ROM/Flash Interface—Single-Byte Read Timing	6-64
6-42	8-Bit ROM/Flash Interface—Two-Byte Read Timing	6-64
6-43	8-Bit ROM/Flash Interface—Cache-Line Read Timing	6-65
6-44	8-, 16-, 32-, or 64-Bit Flash Write Access Timing	6-66
6-45	Port X Peripheral Interface Block Diagram	6-67
6-46	Example of Port X Peripheral Connected to the MPC8245	6-67
6-47	Port X Read Access Timing	6-70
6-48	Port X Write Access Timing	6-70
6-49	Port X Handshake Mode Read Timing	6-71
6-50	Port X Handshake Mode Write Timing	6-72
6-51	PCI Read from ROM/Port X 64-Bit	6-74
6-52	PCI Read from ROM/Port X 8-Bit	6-75
7-1	Internal Processor DMA Arbitration for PCI Bus	7-5
7-2	PCI Arbitration Example	7-8
7-3	PCI Single-Beat Read Transaction	7-16
7-4	PCI Burst Read Transaction	7-16
7-5	PCI Single-Beat Write Transaction	7-17
7-6	PCI Burst Write Transaction	7-17
7-7	PCI Target-Initiated Terminations	7-22
7-8	DAC Single-Beat Read Example	7-23
7-9	DAC Burst Read Example	7-24
7-10	DAC Single-Beat Write Example	7-24
7-11	DAC Burst Write Example	7-24
7-12	Standard PCI Configuration Header	7-25
7-13	CONFIG_ADDR Register Format	7-27
7-14	Type 0 Configuration Translation	7-28
7-15	PCI Parity Operation	7-35
8-1	DMA Controller Block Diagram	8-2
8-2	DMA Controller General Flow	8-8
8-3	Chaining of DMA Descriptors in Memory	8-16
8-4	DMA Mode Register (DMR)	8-18
8-5	DMA Status Register (DSR)	8-22
8-6	Current Descriptor Address Register (CDAR)	8-24
8-7	High Current Descriptor Address Register (HCDAR)	8-25
8-8	Source Address Register (SAR)	8-25
8-9	High Source Address Register (HSAR)	8-26
8-10	Destination Address Register (DAR)	8-26
8-11	High Destination Address Register (HDAR)	8-27
8-12	Byte Count Register (BCR)	8-28

Figures

Figure Number	Title	Page Number
8-13	Next Descriptor Address Register (NDAR)	8-28
8-14	High Next Descriptor Address Register (HNDAR)	8-29
9-1	Message Registers (IMRs and OMRs)	9-3
9-2	Inbound Doorbell Register (IDBR)	9-3
9-3	Outbound Doorbell Register (ODBR)	9-4
9-4	I_2O Message Queue Example	9-6
9-5	Outbound Message Interrupt Status Register (OMISR)	9-10
9-6	Outbound Message Interrupt Mask Register (OMIMR)	9-12
9-7	Inbound FIFO Queue Port Register (IFQPR)	9-12
9-8	Outbound FIFO Queue Port Register (OFQPR)	9-13
9-9	Inbound Message Interrupt Status Register (IMISR)	9-14
9-10	Inbound Message Interrupt Mask Register (IMIMR)	9-16
9-11	Inbound Free_FIFO Head Pointer Register (IFHPR)	9-17
9-12	Inbound Free_FIFO Tail Pointer Register (IFTPR)	9-18
9-13	Inbound Post_FIFO Head Pointer Register (IPHPR)	9-18
9-14	Inbound Post_FIFO Tail Pointer Register (IPTPR)	9-19
9-15	Outbound Free_FIFO Head Pointer Register (OFHPR)	9-19
9-16	Outbound Free_FIFO Tail Pointer Register (OFTPR)	9-20
9-17	Outbound Post_FIFO Head Pointer Register (OPHPR)	9-21
9-18	Outbound Post_FIFO Tail Pointer Register (OPTPR)	9-21
9-19	Messaging Unit Control Register (MUCR)	9-22
9-20	Queue Base Address Register (QBAR)	9-23
10-1	I^2C Interface Block Diagram	10-3
10-2	I^2C Interface Transaction Protocol	10-4
10-3	I^2C Address Register (I2CADR)	10-8
10-4	I^2C Frequency Divider Register (I2CFDR)	10-8
10-5	I^2C Control Register (I2CCR)	10-11
10-6	I^2C Status Register (I2CSR)	10-13
10-7	I^2C Data Register (I2CDR)	10-14
10-8	Example I^2C Interrupt Service Routine Flowchart	10-19
11-1	PIC Unit Block Diagram	11-3
11-2	PIC Interrupt Generation Block Diagram—Nonprogrammable Registers	11-9
11-3	Serial Interrupt Interface Protocol	11-12
11-4	Feature Reporting Register (FRR)	11-16
11-5	Global Configuration Register (GCR)	11-16
11-6	PIC Interrupt Configuration Register (ICR)	11-17
11-7	PIC Vendor Identification Register (EVI)	11-18
11-8	Processor Initialization Register (PI)	11-19
11-9	Spurious Vector Register (SVR)	11-19
11-10	Timer Frequency Reporting Register (TFRR)	11-20
11-11	Timer Control Register	11-21

Figures

Figure Number	Title	Page Number
11-12	Global Timer Current Count Register (GTCCR)	11-22
11-13	Global Timer Base Count Register (GTBCR)	11-23
11-14	Global Timer Vector/Priority Registers (GTVPR)	11-23
11-15	Global Timer Destination Register (GTDR)	11-24
11-16	Direct and Serial Interrupt Vector/Priority Registers (IVPRs and SVPRs)	11-25
11-17	Direct and Serial Destination Registers (IDR and SIR)	11-27
11-18	Processor Current Task Priority Register (PCTPR)	11-28
11-19	Processor Interrupt Acknowledge Register (IACK)	11-29
11-20	Processor End of Interrupt Register (EOI)	11-30
12-1	UART Block Diagram	12-3
12-2	Single UART/DUART Mode Signal Multiplexing	12-4
12-3	UART Bus Interface Transaction Protocol Example	12-9
12-4	Receiver Register (URBR)	12-14
12-5	Divisor Register (UDMB, UDLB)	12-15
12-6	Transmitter Holding Register (UTHR)	12-16
12-7	Interrupt Enable Register (UIER)	12-16
12-8	Interrupt ID Register (UIIR)	12-18
12-9	FIFO Control Register (UFCR)	12-19
12-10	Line Control Register (ULCR)	12-21
12-11	Modem Control Register (UMCR)	12-22
12-12	Line Status Register (ULSR)	12-23
12-13	Modem Status Register (UMSR)	12-24
12-14	Scratch Register (USCR)	12-25
12-15	Alternate Function Register (UAFR)	12-26
12-16	DMA Status Register (UDSR)	12-26
12-17	DUART Configuration Register (DCR)	12-29
13-1	MPC8245 Internal Buffer Organization	13-2
13-2	Processor/Local Memory Buffers	13-3
13-3	Processor/PCI Buffers	13-4
13-4	PCI/Local Memory Buffers	13-6
13-5	PCI/DMA Arbitration for Local Memory Accesses	13-10
14-1	Internal Error Management Block Diagram	14-2
15-1	MPC8245 Peripheral Logic Power States	15-8
16-1	Overflow Example	16-3
16-2	Performance Monitor Counter Registers (PMC0–PMC3)	16-5
16-3	Pipelined Processor Transaction and End-of-Data (EOD)	16-6
16-4	Processor Latency	16-6
16-5	PCI Latency	16-7
16-6	Command Type 0 Threshold Example	16-15
16-7	Processor Burstiness Example	16-16
17-1	Example PCI Address Attribute Signal Timing for Burst Read Operations	17-5

Figures

Figure Number	Title	Page Number
17-2	Example PCI Address Attribute Signal Timing for Burst Write Operations	17-5
17-3	64-Bit SDRAM Physical Address for Debug	17-7
17-4	32-Bit SDRAM Physical Address for Debug	17-7
17-5	64-Bit ROM/Flash Physical Address for Debug	17-8
17-6	32-Bit ROM/Flash Physical Address for Debug	17-8
17-7	16-Bit ROM/Flash Physical Address for Debug	17-8
17-8	8-Bit ROM/Flash Physical Address for Debug	17-8
17-9	SDRAM Debug Address, $\overline{\text{MIV}}$, and MAA Timings for Burst Read Operation	17-11
17-10	SDRAM Debug Address, $\overline{\text{MIV}}$, and MAA Timings for Burst Write Operation	17-12
17-11	Example ROM Debug Address, $\overline{\text{MIV}}$, and MAA Timings For Burst Read	17-13
17-12	Example Flash Debug Address, $\overline{\text{MIV}}$, and MAA Timings For Single-Byte Read	17-14
17-13	Example Flash Debug Address, $\overline{\text{MIV}}$, and MAA Timings for Write Operation	17-15
17-14	Functional Diagram of Memory Data-Path Error Injection	17-16
17-15	Data High Error Injection Mask—Offsets 0xF_F000, 0xF00	17-16
17-16	Data Low Error Injection Mask—Offsets 0xF_F004, 0xF04	17-17
17-17	Parity Error Injection Mask—Offsets 0xF_F008, 0xF08	17-17
17-18	Data High Error Capture Monitor—Offsets 0xF_F00C, 0xF0C	17-18
17-19	Data Low Error Capture Monitor—Offsets 0xF_F010, 0xF10	17-18
17-20	Parity Error Capture Monitor—Offsets 0xF_F014, 0xF14	17-19
17-21	JTAG Interface Block Diagram	17-20
18-1	Watchpoint Facility Signal Interface	18-1
18-2	Watchpoint #1 Control Trigger Register (WP1_CNTL_TRIG)—Offsets 0xF_F018, 0xF18	18-5
18-3	Watchpoint #2 Control Trigger Register (WP2_CNTL_TRIG)—Offsets 0xF_F030, 0xF30	18-5
18-4	Watchpoint #1 Address Trigger Register (WP1_ADDR_TRIG)—Offsets 0xF_F01C, 0xF1C	18-6
18-5	Watchpoint #2 Address Trigger Register (WP2_ADDR_TRIG)—Offsets 0xF_F034, 0xF34	18-6
18-6	Bit Match Generation for Watchpoint Trigger Bit Settings	18-7
18-7	Watchpoint #1 Control Mask Register (WP1_CNTL_MASK)—Offsets 0xF_F020, 0xF20	18-7
18-8	Watchpoint #2 Control Mask Register (WP2_CNTL_MASK)—Offsets 0xF_F038, 0xF38	18-7
18-9	Watchpoint #1 Address Mask Register (WP1_ADDR_MASK)—Offsets 0xF_F024, 0xF24	18-9
18-10	Watchpoint #2 Address Mask Register (WP2_ADDR_MASK)—Offsets 0xF_F03C, 0xF3C	18-9
18-11	Watchpoint Control Register (WP_CONTROL)—Offsets 0xF_F048, 0xF48	18-10
18-12	Watchpoint Facility State Diagram	18-14

Figures

Figure Number	Title	Page Number
18-13	Watchpoint Facility Block Diagram	18-15
A-1	Four-Byte Transfer to PCI Memory Space—Big-Endian Mode	A-3
A-2	Big-Endian Memory Image in Local Memory	A-4
A-3	Big-Endian Memory Image in Big-Endian PCI Memory Space	A-5
A-4	Munged Memory Image in Local Memory	A-7
A-5	Little-Endian Memory Image in Little-Endian PCI Memory Space	A-8
A-6	One-Byte Transfer to PCI Memory Space—Little-Endian Mode	A-9
A-7	Two-Byte Transfer to PCI Memory Space—Little-Endian Mode	A-10
A-8	Four-Byte Transfer to PCI Memory Space—Little-Endian Mode	A-11
A-9	One-Byte Transfer to PCI I/O Space—Little-Endian Mode	A-12
A-10	Two-Byte Transfer to PCI I/O Space—Little-Endian Mode	A-13
A-11	Four-Byte Transfer to PCI I/O Space—Little-Endian Mode	A-14
D-1	MPC8245 Processor Programming Model—Registers	D-3
D-2	General-Purpose Registers (GPRs)	D-4
D-3	Floating-Point Registers (FPRs)	D-4
D-4	Condition Register (CR)	D-4
D-5	Floating-Point Status and Control Register (FPSCR)	D-6
D-6	XER Register	D-8
D-7	Link Register (LR)	D-9
D-8	Count Register (CTR)	D-9
D-9	Time Base (TB)	D-10
D-10	Machine State Register (MSR)	D-14
D-11	Processor Version Register (PVR)	D-16
D-12	Upper BAT Register	D-16
D-13	Lower BAT Register	D-16
D-15	Segment Register Format (T = 0)	D-18
D-14	SDR1 Register Format	D-18
D-16	SPRG0–SPRG3	D-19
D-17	DSISR	D-19
D-18	Machine Status Save/Restore Register 0 (SRR0)	D-20
D-19	Machine Status Save/Restore Register 1 (SRR1)	D-20
D-20	Decrementer Register (DEC)	D-20
D-21	External Access Register (EAR)	D-21
D-22	DMISS and IMISS Registers	D-22
D-23	DCMP and ICMP Registers	D-22
D-24	HASH1 and HASH2 Registers	D-23
D-25	Required Physical Address Register (RPA)	D-23
D-26	Instruction Address Breakpoint Register (IABR)	D-24
D-27	Hardware Implementation Register 0 (HID0)	D-25
D-28	Hardware Implementation Register 1 (HID1)	D-28
D-29	Hardware Implementation-Dependent Register 2 (HID2)	D-29

Tables

Table Number	Title	Page Number
i	Acronyms and Abbreviated Terms	xlviii
1-1	Peripheral Logic Power Modes Summary	1-22
1-2	Programmable Peripheral Logic Power Modes Summary	1-23
1-3	Differences Between the MPC8245 and the MPC8240	1-25
2-1	MPC8245 Signal Cross Reference	2-4
2-2	Output Signal States During System Reset	2-8
2-3	PCI Command Encodings	2-12
2-4	Memory Data Bus Byte Lane Assignments	2-21
2-5	MPC8245 Reset Configuration Signals	2-44
3-1	Address Map B—Processor View in Host Mode	3-2
3-2	Address Map B—PCI Memory Master View in Host Mode	3-2
3-3	Address Map B—PCI Memory Master View in Agent Mode	3-3
3-4	Address Map B—PCI I/O Master View	3-3
3-5	Address Map B—Processor View in Host Mode Options	3-8
3-6	Address Map B—PCI Memory Master View in Host Mode Options	3-10
3-7	ATU Register Summary	3-19
3-8	Bit Settings for LMBARn—0x10 and 0x18	3-20
3-9	Bit Settings for ITWRn—0x0_2310 and 0x0_2330	3-22
3-10	Bit Settings for OTHBARn—0x0_0230C and 0x0_232C	3-23
3-11	Bit Settings for OMBARn—0x0_2300 and 0x0_2320	3-24
3-12	Bit Settings for OTWRn—0x0_2308 and 0x0_2328	3-25
3-13	Embedded Utilities Local Memory Register Summary	3-27
3-14	Embedded Utilities Peripheral Control and Status Register Summary	3-30
4-1	Configuration Registers Accessible from the Processor Core	4-4
4-2	Configuration Registers Accessible from the PCI Bus	4-8
4-3	PCI Configuration Space Header Summary	4-9
4-4	Bit Settings for PCI Command Register—0x04	4-11
4-5	Bit Settings for PCI Status Register—0x06	4-12
4-6	Programming Interface—0x09	4-13
4-7	PCI Base Class Code—0x0B	4-14
4-8	Cache Line Size Register—0x0C	4-14
4-9	Latency Timer Register—0x0D	4-14
4-10	Local Memory Base Address Register Bit Definitions—Offsets 0x10, 0x18	4-15
4-11	PCSR Base Address Register Bit Definitions—0x14	4-15
4-12	Subsystem Vendor ID—0x2C	4-15

Tables

Table Number	Title	Page Number
4-13	Subsystem ID—0x2E	4-16
4-14	Interrupt Line Register—0x3C	4-16
4-15	PCI General Control Register Bit Definitions—0x44	4-16
4-16	PCI Arbiter Control Register Bit Definitions—0x46	4-17
4-17	Bit Settings for Power Management Configuration Register 1—0x70	4-19
4-18	Power Management Configuration Register 2—0x72	4-21
4-19	Output Driver Control Register Bit Definitions—0x73	4-22
4-20	CLK Driver Control Register Bit Definitions—0x74	4-23
4-21	Miscellaneous I/O Control Register 1 Bit Definitions—0x76	4-24
4-22	Miscellaneous I/O Control Register 2 Bit Definitions—0x77	4-24
4-23	Embedded Utilities Memory Base Address Register—0x78	4-25
4-24	Bit Settings for Memory Starting Address Registers 1 and 2	4-26
4-25	Bit Settings for Extended Memory Starting Address Registers 1 and 2	4-27
4-26	Bit Settings for Memory Ending Address Registers 1 and 2	4-28
4-27	Bit Settings for Extended Memory Ending Address Registers 1 and 2	4-29
4-28	Bit Settings for Memory Bank Enable Register—0xA0	4-30
4-29	Bit Settings for Memory Page Mode Register—0xA3	4-30
4-30	Bit Settings for PICR1—0xA8	4-31
4-31	Bit Settings for PICR2—0xAC	4-33
4-32	Bit Settings for ECC Single-Bit Error Counter Register—0xB8	4-35
4-33	Bit Settings for ECC Single-Bit Error Trigger Register—0xB9	4-36
4-34	Bit Settings for Error Enabling Register 1 (ErrEnR1)—0xC0	4-37
4-35	Bit Settings for Error Detection Register 1 (ErrDR1)—0xC1	4-38
4-36	Bit Settings for Internal Processor Bus Error Status Register—0xC3	4-39
4-37	Bit Settings for Error Enabling Register 2 (ErrEnR2)—0xC4	4-39
4-38	Bit Settings for Error Detection Register 2 (ErrDR2)—0xC5	4-40
4-39	Bit Settings for PCI Bus Error Status Register—0xC7	4-41
4-40	Bit Settings for Processor/PCI Error Address Register—0xC8	4-42
4-41	Extended ROM Configuration Register 1—0xD0	4-43
4-42	Extended ROM Configuration Register 2—0xD4	4-46
4-44	Extended ROM Configuration Register 4—0xDC	4-49
4-43	Extended ROM Configuration Register 3—0xD8	4-49
4-45	Bit Settings for the AMBOR—0xE0	4-50
4-46	Bit Settings for this register—0xE1	4-52
4-47	Bit Settings for the PCR—0xE2	4-52
4-48	Bit Settings for this Register—0xE3	4-53
4-49	Bit Settings for MCCR1—0xF0	4-54
4-50	Bit Settings for MCCR2—0xF4	4-57
4-51	Bit Settings for MCCR3—0xF8	4-59
4-52	Bit Settings for MCCR4—0xFC	4-60
5-1	HID0 Field Descriptions	5-14

Tables

Table Number	Title	Page Number
5-2	HID0[BCLK] and HID0[ECLK] CKO Signal Configuration	5-17
5-3	HID1 Field Descriptions	5-18
5-4	HID2 Field Descriptions	5-18
5-5	CCU Responses to Processor Transactions	5-26
5-6	Transactions Reflected to the Processor for Snooping	5-27
5-7	Exception Classifications for the Processor Core	5-29
5-8	Exceptions and Conditions	5-30
5-9	Integer Divide Latency	5-36
5-10	Major Differences Between the MPC8245 Core and the MPC603e	5-36
6-1	Memory Interface Signal Summary	6-3
6-2	Memory Address Signal Mappings	6-4
6-3	SDRAM Data Bus Lane Assignments	6-7
6-4	Unsupported Multiplexed Row and Column Address Bits	6-9
6-5	Supported SDRAM Device Configurations	6-10
6-6	SDRAM Address Multiplexing SDBA[1:0] and SDMA[12:0]—64-Bit Mode	6-12
6-7	SDRAM Address Multiplexing SDBA[1:0] and SDMA[12:0]—32-Bit Mode	6-14
6-8	Memory Data-Path Parameters	6-15
6-9	SDRAM System Configurations	6-16
6-10	MPC8245 SDRAM Interface Commands	6-19
6-11	SDRAM Interface Timing Intervals	6-23
6-12	MPC8245 SDRAM ECC Syndrome Encoding (Data Bits 0-31)	6-30
6-13	The MPC8245 SDRAM ECC Syndrome Encoding (Data Bits 32-63)	6-31
6-14	SDRAM Controller Power-Saving Configurations	6-37
6-15	SDRAM Power-Saving Modes Refresh Configuration	6-37
6-16	Base ROM Address and Data Bus Configurations	6-52
6-17	Extended ROM Address and Data Bus Configurations	6-57
6-18	ROM Timing Configuration Parameters	6-61
6-19	Port X $\overline{AS}$ Timing Parameters	6-69
7-1	PCI Arbiter Control Register Parking Mode Bits	7-8
7-2	PCI Bus Commands	7-10
7-3	Supported Combinations of AD[1:0]	7-12
7-4	Disconnect Timing for PCI Write to Local/Extended ROM	7-20
7-5	PCI Configuration Space Header Summary	7-26
7-6	CONFIG_ADDR Register Fields	7-27
7-7	Type 0 Configuration—Device Number to IDSEL Translation	7-29
7-8	Special-Cycle Message Encodings	7-32
7-9	Initialization Options for PCI Controller	7-36
8-1	DMA Register Summary	8-2
8-2	DMA Descriptor Summary	8-15
8-3	DMR Field Descriptions—Offsets 0x100, 0x200	8-19
8-4	DSR Field Descriptions—Offsets 0x104, 0x204	8-22

Tables

Table Number	Title	Page Number
8-5	CDAR Field Descriptions—Offsets 0x108, 0x208	8-24
8-6	HCDAR Field Description—Offsets 0x10C, 0x20C	8-25
8-7	SAR Field Description—Offsets 0x110, 0x210	8-25
8-8	HSAR Field Description—Offsets 0x114, 0x214	8-26
8-9	DAR Field Description—Offsets 0x118, 0x218	8-27
8-10	HDAR Field Description—Offsets 0x11C, 0x21C	8-27
8-11	BCR Field Descriptions—Offsets 0x120, 0x220	8-28
8-12	NDAR Field Descriptions—Offsets 0x124, 0x224	8-29
8-13	HNDAR Field Description—Offsets 0x128, 0x228	8-29
9-1	Message Register Summary	9-2
9-2	IMR and OMR Field Descriptions— Offsets 0x050–0x05C, 0x0_0050–0x0_005C	9-3
9-3	IDBR Field Descriptions—Offsets 0x068, 0x0_0068	9-3
9-4	ODBR Field Descriptions—Offsets 0x060, 0x0_0060	9-4
9-5	I_2O PCI Configuration Identification Register Settings	9-5
9-6	I_2O Register Summary	9-5
9-7	Queue Starting Address	9-7
9-8	OMISR Field Descriptions—Offset 0x030	9-10
9-9	OMIMR Field Descriptions—Offset 0x034	9-12
9-10	IFQPR Field Descriptions—Offset 0x040	9-13
9-11	OFQPR Field Descriptions—Offset 0x044	9-13
9-12	IMISR Field Descriptions—Offset 0x0_0100	9-14
9-13	IMIMR Field Descriptions—Offset 0x0_0104	9-16
9-14	IFHPR Field Descriptions—Offset 0x0_0120	9-17
9-15	IFTPR Field Descriptions—Offset 0x0_0128	9-18
9-16	IPHPR Field Descriptions—Offset 0x0_0130	9-18
9-17	IPTPR Field Descriptions—Offset 0x0_0138	9-19
9-18	OFHPR Field Descriptions—Offset 0x0_0140	9-20
9-19	OFTPR Field Descriptions—Offset 0x0_0148	9-20
9-20	OPHPR Field Descriptions—Offset 0x0_0150	9-21
9-21	OPTPR Field Descriptions— Offset 0x0_0158	9-22
9-22	MUCR Field Descriptions— Offset 0x0_0164	9-22
9-23	QBAR Field Descriptions— Offset 0x0_0170	9-23
10-1	I^2C Interface Signal Description	10-2
10-2	I^2C Register Summary	10-3
10-3	I2CADR Field Descriptions—Offset 0x0_3000	10-8
10-4	I2CFDR Field Descriptions—Offset 0x0_3004	10-9
10-5	Serial Bit Clock Frequency Divider Selections	10-9
10-6	I2CCR Field Descriptions—Offset 0x0_3008	10-11
10-7	I2CSR Field Descriptions—Offset 0x0_300C	10-13
10-8	I2CDR Field Descriptions—Offset 0x0_3010	10-15

Tables

Table Number	Title	Page Number
11-1	PIC Interface Signal Description	11-2
11-2	PIC Register Address Map—Global and Timer Registers	11-4
11-3	PIC Register Address Map—Interrupt Source Configuration Registers	11-5
11-4	PIC Register Address Map—Processor-Related Registers	11-7
11-5	FRR Field Descriptions—Offset 0x4_1000	11-16
11-6	GCR Field Descriptions—Offset 0x4_1020	11-17
11-7	ICR Field Descriptions—Offset 0x4_1030	11-17
11-8	EVI Register Field Descriptions—Offset 0x4_1080	11-18
11-9	PI Register Field Descriptions—Offset 0x4_1090	11-19
11-10	SVR Field Descriptions—Offset 0x4_10E0	11-20
11-11	TFRR Field Descriptions—Offset 0x4_10F0	11-20
11-12	TCR Field Descriptions—Offset 0x4_10F4	11-21
11-13	EUMBBAR Offsets for GTCCRs	11-22
11-14	GTCCR Field Descriptions	11-22
11-15	EUMBBAR Offsets for GTBCRs	11-22
11-16	GTBCR Field Descriptions	11-23
11-17	EUMBBAR Offsets for GTVPRs	11-23
11-18	GTVPRs Field Descriptions	11-24
11-19	EUMBBAR Offsets for GTDRs	11-24
11-20	GTDRs Field Descriptions	11-25
11-21	EUMBBAR Offsets for IVPRs and SVPRs	11-25
11-22	IVPR and SVPR Field Descriptions	11-26
11-23	EUMBBAR Offsets for IDRs and SIRs	11-26
11-24	IDRs and SIRs Field Descriptions	11-27
11-25	EUMBBAR Offsets for IIVPRs	11-27
11-26	EUMBBAR Offsets for IIDRs	11-28
11-27	PCTPR Field Descriptions—Offset 0x6_0080	11-29
11-28	IACK Field Descriptions—Offset 0x6_00A0	11-29
11-29	EOI Field Descriptions—Offset 0x6_00B0	11-30
12-1	DUART Signal Descriptions	12-3
12-2	DUART Register Summary	12-5
12-3	Bit Settings for URBR—Offsets 0x500, 0x600	12-14
12-4	Bit Settings for Divisor Register UDMB, UDLB—Offsets 0x501/0x601, 0x500/0x600	12-15
12-5	Baud Rate Examples	12-15
12-6	Bit Settings for UTHR—Offsets 0x500, 0x600	12-16
12-7	Bit Settings for UIER—Offsets 0x501, 0x601	12-17
12-8	Bit Settings for UIIR—Offsets 0x502, 0x602	12-18
12-9	UIIR IID Bits Summary	12-18
12-10	Bit Settings for UFCR—Offsets 0x502, 0x602	12-19
12-11	UFCR’s Receiver Trigger Level	12-20

Tables

Table Number	Title	Page Number
12-12	Bit Settings for ULCR—Offsets 0x503, 0x603	12-21
12-13	Parity Selection Using ULCR[PEN], ULCR[SP], and ULCR[EPS]	12-22
12-14	Bit Settings for UMCR—Offsets 0x504, 0x604	12-22
12-15	Bit Settings for ULSR—Offsets 0x505, 0x605	12-23
12-16	Bit Settings for UMSR—Offsets 0x506, 0x606	12-25
12-17	Bit Settings for USCR—Offsets 0x507, 0x607	12-25
12-18	Bit Settings for UAFR—Offsets 0x502, 0x602	12-26
12-19	Bit Settings for UDSR—Offsets 0x510, 0x610	12-26
12-20	Bit Settings for DCR—Offsets 0x511, 0x611	12-29
13-1	Snooping Behavior Caused by a Hit in an Internal Buffer	13-7
13-2	Internal Arbitration Priorities	13-12
14-1	MPC8245 Error Priorities	14-3
14-2	Processor Write Parity Checking	14-8
15-1	Programmable Processor Power Modes	15-3
15-2	Peripheral Logic Power Modes Summary	15-9
16-1	Performance Monitor Register Summary	16-1
16-2	Command Register (CMDR)	16-2
16-3	Monitor Mode Control Register (MMCR)	16-3
16-4	PMCn Field Descriptions	16-5
16-5	Command Type 0—Processor Transactions	16-8
16-6	Command Type 1—Event Encodings	16-8
16-7	DUART Baud Rate Error Example	16-17
16-8	Interrupt Latency Example	16-19
16-9	PCI Utilization Example	16-21
16-10	PCI Efficiency Example	16-22
16-11	DMA Channel Busy Example	16-24
16-12	DMA Segment Busy Example	16-24
17-1	Memory Data-Path Diagnostic Register Offsets	17-2
17-2	Address Attribute Signal Summary	17-2
17-3	Memory Address Attribute Signal Encodings	17-2
17-4	PCI Attribute Signal Encodings	17-3
17-5	Memory Debug Address Signal Definitions	17-6
17-6	Example of $\overline{CS}$ Encoding for 568-Mbyte Memory System	17-9
17-7	Memory Interface Valid Signal Definition	17-10
17-8	Data High Error Injection Mask Bit Field Definitions	17-16
17-9	Data Low Error Injection Mask Bit Field Definitions	17-17
17-10	Parity Error Injection Mask Bit Field Definitions	17-17
17-11	Data High Error Capture Monitor Bit Field Definitions	17-18
17-12	Data Low Error Capture Monitor Bit Field Definitions	17-19
17-13	Parity High Error Capture Monitor Bit Field Definitions	17-19
18-1	Watchpoint Signal Summary	18-3

Tables

Table Number	Title	Page Number
18-2	Watchpoint Register Offsets	18-4
18-3	Watchpoint Control Trigger Register Bit Field Definitions	18-5
18-4	Watchpoint Address Trigger Register Bit Field Definitions	18-6
18-5	Watchpoint Control Mask Register Bit Field Definitions	18-8
18-6	Watchpoint Address Mask Register Bit Field Definitions	18-9
18-7	Watchpoint Control Register Bit Field Definitions	18-10
18-8	Watchpoint Monitor Mode Select	18-12
A-1	Byte Lane Translation in Big-Endian Mode	A-2
A-2	Processor Address Modification for Individual Aligned Scalars	A-6
A-3	MPC8245 Address Modification for Individual Aligned Scalars	A-6
A-4	Byte Lane Translation in Little-Endian Mode	A-7
C-1	Complete Instruction List Sorted by Mnemonic	C-1
C-2	Complete Instruction List Sorted by Opcode	C-9
C-3	Integer Arithmetic Instructions	C-17
C-4	Integer Compare Instructions	C-18
C-5	Integer Logical Instructions	C-18
C-6	Integer Rotate Instructions	C-19
C-7	Integer Shift Instructions	C-19
C-8	Floating-Point Arithmetic Instructions	C-19
C-9	Floating-Point Multiply-Add Instructions	C-20
C-10	Floating-Point Rounding and Conversion Instructions	C-20
C-11	Floating-Point Compare Instructions	C-20
C-12	Floating-Point Status and Control Register Instructions	C-20
C-13	Integer Load Instructions	C-21
C-14	Integer Store Instructions	C-21
C-15	Integer Load and Store with Byte-Reverse Instructions	C-22
C-16	Integer Load and Store Multiple Instructions	C-22
C-17	Integer Load and Store String Instructions	C-22
C-18	Memory Synchronization Instructions	C-22
C-19	Floating-Point Load Instructions	C-23
C-20	Floating-Point Store Instructions	C-23
C-21	Floating-Point Move Instructions	C-23
C-22	Branch Instructions	C-24
C-23	Condition Register Logical Instructions	C-24
C-24	System Linkage Instructions	C-24
C-25	Trap Instructions	C-24
C-26	Processor Control Instructions	C-24
C-27	Cache Management Instructions	C-25
C-28	Segment Register Manipulation Instructions	C-25
C-29	Lookaside Buffer Management Instructions	C-25
C-30	External Control Instructions	C-26

Tables

Table Number	Title	Page Number
C-31	I-Form	C-27
C-32	B-Form	C-27
C-33	SC-Form	C-27
C-34	D-Form	C-27
C-35	DS-Form	C-29
C-36	X-Form	C-29
C-37	XL-Form	C-33
C-38	XFX-Form	C-34
C-39	XFL-Form	C-34
C-40	XS-Form	C-34
C-41	XO-Form	C-35
C-42	A-Form	C-35
C-43	M-Form	C-36
C-44	MD-Form	C-37
C-45	MDS-Form	C-37
C-46	PowerPC Instruction Set Legend	C-39
D-1	Bit Settings for CR0 Field of CR	D-5
D-2	Bit Settings for CR1 Field of CR	D-5
D-3	CR*n* Field Bit Settings for Compare Instructions	D-5
D-4	FPSCR Bit Settings	D-6
D-5	Floating-Point Result Flags in FPSCR	D-8
D-6	XER Bit Definitions	D-9
D-7	BO Operand Encodings	D-10
D-8	MSR Bit Settings	D-14
D-9	Floating-Point Exception Mode Bits	D-15
D-10	BAT Registers—Field and Bit Descriptions	D-17
D-11	BAT Area Lengths	D-17
D-12	SDR1 Bit Settings	D-18
D-13	Segment Register Bit Settings (T = 0)	D-18
D-14	Conventional Uses of SPRG0–SPRG3	D-19
D-15	External Access Register (EAR) Bit Settings	D-21
D-16	DCMP and ICMP Bit Settings	D-22
D-17	HASH1 and HASH2 Bit Settings	D-23
D-18	RPA Bit Settings	D-24
D-19	Instruction Address Breakpoint Register Bit Settings	D-24
D-20	HID0 Field Descriptions	D-25
D-21	HID0[BCLK] and HID0[ECLK] CKO Signal Configuration	D-28
D-22	HID1 Field Descriptions	D-29
D-23	HID2 Field Descriptions	D-29

About This Book

The primary objective of this manual is to describe the functionality of the MPC8245 and the MPC8241 PowerPC™ integrated processors. Unless noted otherwise, descriptions in this manual that refer to the MPC8245 apply to the MPC8241. The MPC8245 processor core is based on the MPC603e low-power microprocessor. It also performs many on-chip peripheral functions.

The MPC603e implements the full 32-bit portion of the PowerPC architecture. Note that this book is intended as a companion to the following publications:

- *MPC603e RISC Microprocessor User's Manual*
- *Programming Environments Manual for 32-Bit Implementations of the PowerPC Architecture*

Contact your local sales representative to obtain this Motorola documentation. Because the PowerPC architecture supports a broad range of processors, the *Programming Environments Manual* provides a general description of features that are common to these processors and indicates features that are optional or may be implemented differently in the design of each processor.

The information is subject to change without notice, as described in the disclaimers on the title page of this book. As with any technical documentation, it is the reader's responsibility to use the most recent version of the documentation. For more information, contact your sales representative.

Audience

This manual is intended for system software and hardware developers and applications programmers who want to develop products using the MPC8245 integrated processor. Readers should understand the following topics:

- operating systems
- microprocessor system design
- basic principles of RISC processing
- details of the PowerPC architecture

Organization

The following list describing the major sections of this manual:

- Chapter 1, “Overview,” provides a general understanding of the features and functions of the MPC8245 device and its component parts.
- Chapter 2, “Signal Descriptions and Clocking,” provides descriptions of the MPC8245 external signals. It describes each signal’s behavior when the signal is asserted and negated and when the signal is an input or an output.
- Chapter 3, “Address Maps,” describes how the MPC8245 in host mode supports the address map B configuration.
- Chapter 4, “Configuration Registers,” describes the programmable configuration registers of the MPC8245.
- Chapter 5, “G2 Processor Core,” provides an overview of the basic functionality of the G2 processor core.
- Chapter 6, “Memory Interface,” describes the memory interface of the MPC8245 and how it controls the processor and PCI interactions to main memory.
- Chapter 7, “PCI Bus Interface,” provides a rudimentary description of PCI bus operations and the implementation of the PCI bus.
- Chapter 8, “DMA Controller,” describes how the DMA controller operates on the MPC8245.
- Chapter 9, “Message Unit (with I2O),” describes a mechanism to facilitate communications between host and peripheral processors.
- Chapter 10, “I2C Interface,” describes the I^2C (inter-integrated circuit) interface on the MPC8245.
- Chapter 11, “Programmable Interrupt Controller (PIC) Unit,” provides a description of a general purpose interrupt controller solution using the PIC module of the MPC8245.
- Chapter 12, “DUART Unit,” describes the two (Dual) Universal Asynchronous Receiver/Transmitters (UARTs) of the MPC8245, including
  - — operation of the two UARTs
  - — DUART initialization sequence
  - — programming details for the DUART registers and features
- Chapter 13, “Central Control Unit,” describes the internal buffering and arbitration logic of the MPC8245 central control unit (CCU).
- Chapter 14, “Error Handling,” describes how the MPC8245 handles different error conditions.
- Chapter 15, “Power Management,” describes the many hardware support features that the MPC8245 provides for power management.

- Chapter 16, “Performance Monitor,” describes the MPC8245 performance monitor facility that monitors bridge logic events such as SDRAM or PCI bus traffic, the DUART, or the number of interrupts emanating from an interrupt controller.
- Chapter 17, “Debug Features,” describes the MPC8245 features that aid in the process of bringing the system up and debugging.
- Chapter 18, “Programmable I/O and Watchpoint” describes the capabilities of the TRIG_IN signal, and generating the TRIG_OUT signal based on programmable watchpoints on the internal processor bus.
- Appendix A, “Bit and Byte Ordering,” describes the big- and little-endian modes and provides examples of each.
- Appendix B, “Initialization Example,” describes an example of an assembly language routine for initializing the configuration registers for the MPC8245 using address map B.
- Appendix C, “PowerPC Instruction Set Listings,” lists the MPC8245 microprocessor’s instruction set and the additional PowerPC instructions that the MPC8245 does not implement.
- Appendix D, “Processor Core Register Summary,” summarizes the register set in the processor core of the MPC8245 as defined by the three programming environments of the PowerPC architecture.
- Appendix E, “Revision History,” contains information about changes made in this document in various revisions.

Suggested Reading

This section lists additional reading that provides background for the information in this manual as well as general information about the PowerPC architecture.

General Information

The following documentation provides useful information about PowerPC architecture and computer architecture:

- The following books are available from the PCI Special Interest Group, P.O. Box 14070, Portland, OR 97214; Tel. (800) 433-5177 (U.S.A.), (503) 797-4207 (International).
  - — *Local Bus Specification, Rev 2.2*
  - — *PCI System Design Guide*, Rev 1.0
- The following books are available from Morgan-Kaufmann Publishers, 340 Pine Street, Sixth Floor, San Francisco, CA:
  - — *The PowerPC Architecture: A Specification for a New Family of RISC Processors*, Second Edition, by International Business Machines, Inc.

For updates, see http://www.austin.ibm.com/tech/ppc-chg.html.

— *PowerPC Microprocessor Common Hardware Reference Platform: A System Architecture*, by Apple Computer, Inc., International Business Machines, Inc., and Motorola, Inc.

— *Computer Architecture: A Quantitative Approach*, Second Edition, by John L. Hennessy and David A. Patterson

— *Computer Organization and Design: The Hardware/Software Interface*, Second Edition, David A. Patterson and John L. Hennessy

Related Documentation

Motorola documentation is available from the sources listed on the back cover of this manual. The document order numbers are included in parentheses for ease in ordering:

- *Programming Environments Manual for 32-Bit Implementations of the PowerPC Architecture* (MPEFPC32B/AD), which describes resources defined by the PowerPC architecture.
- The *G2 PowerPC™ Core Reference Manual*, which describes features for the embedded G2 processor core, a derivative of the original MPC603e PowerPC microprocessor design.
- The *Tsi107™ PowerPC Host Bridge User Manual*, published by Tundra Semiconductor Corporation (Tundra). See the Tundra website at www.tundra.com for more information.
- User's manuals—These books provide details about individual implementations and are intended for use with the *Programming Environments Manual.*
- Addenda/errata to user's manuals—Because some processors have follow-on parts, an addendum describes the additional features and functionality changes. These addenda are intended for use with the corresponding user's manuals.
- Hardware specifications—Hardware specifications provide specific data about bus timing, signal behavior, and AC, DC, and thermal characteristics, as well as other design considerations. Separate hardware specifications are provided for each part described in this book.
- Technical summaries—Each device has a technical summary that provides an overview of its features. This document is roughly equivalent to the overview (Chapter 1) of a user's manual for implementation.
- *The Programmer's Reference Guide for the PowerPC Architecture*: MPCPRG/D—This concise reference includes the register summary, memory control model, exception vectors, and the PowerPC instruction set.
- *The Programmer's Pocket Reference Guide for the PowerPC Architecture*: MPCPRGREF/D—This foldout card provides an overview of PowerPC registers, instructions, and exceptions for 32-bit implementations.

- Application notes—These useful short documents address specific design issues for programmers and engineers who work with Motorola processors.

Additional literature is published as new processors become available. For a current list of documentation, refer to http://www.motorola.com/motorola.

Conventions

This document uses the following notational conventions:

cleared/set	The words ‘set’ and ‘cleared’ are reserved for use with bits and fields, but not signals. A bit or field is *cleared* when it contains the value zero. A bit is *set* when it contains the value one. However, a field can be set to a value that contains zeros and ones.
asserted/negated	The words ‘asserted’ and ‘negated’ are reserved for use with signals and not bits.
mnemonics	Instruction mnemonics are shown in lowercase bold.
italics	Italics indicate variable command parameters, for example, **bcctr***x*.
	Book titles in text are set in italics.
	Internal signals are set in italics, for example, $\overline{qual\ BG}$.
0x0	Prefix to denote hexadecimal number
0b0	Prefix to denote binary number
rA, **r**B	Instruction syntax that identifies a source GPR
rD	Instruction syntax that identifies a destination GPR
frA, **fr**B, **fr**C	Instruction syntax that identifies a source FPR
frD	Instruction syntax that identifies a destination FPR
REG[FIELD]	Abbreviations for registers are shown in uppercase text. Specific bits, fields, or ranges appear in brackets. For example, MSR[LE] refers to the little-endian mode enable bit in the machine state register.
x	In some contexts, such as signal encodings, an unitalicized x indicates a 'don’t care' logic.
x	An italicized *x* indicates an alphanumeric variable.
n	An italicized *n* indicates an numeric variable.
¬	NOT logical operator
&	AND logical operator
|	OR logical operator
0 0 0 0	Indicates reserved bits or bit fields in a register. Although these bits can be written to as ones or zeros, they are always read as zeros.

Acronyms and Abbreviations

Table i contains acronyms and abbreviations that appear in this document.

Table i. Acronyms and Abbreviated Terms

Term	Meaning
ALU	Arithmetic logic unit
BAT	Block address translation
BGA	Ball grid array package
BIST	Built-in self test
BIU	Bus interface unit
BPU	Branch processing unit
CAR	Cache address register
CAS	Column address strobe
CBR	CAS before RAS
CIA	Current instruction address
CMOS	Complementary metal-oxide semiconductor
CR	Condition register
CRTRY	Cache retry queue
CTR	Count register
DAC	Dual address cycle
DAR	Data address register
DBAT	Data BAT
DCMP	Data TLB compare
DEC	Decrementer register
DIMM	Dual inline memory module
DRAM	Dynamic random access memory
DMISS	Data TLB miss address
DSISR	Register for determining the source of a DSI exception
DTLB	Data translation lookaside buffer
DUART	Dual universal asynchronous receiver/transmitter
EA	Effective address
EAR	External access register
ECC	Error checking and correction
EDO	Extended data out DRAM
PIC	Programmable interrupt controller
ErrDR	Error detection register

Table i. Acronyms and Abbreviated Terms (continued)

Term	Meaning
ErrEnR	Error enabling register
FIFO	First-in-first-out
FPR	Floating-point register
FPSCR	Floating-point status and control register
FPU	Floating-point unit
GPR	General-purpose register
HASH1	Primary hash address
HASH2	Secondary hash address
IABR	Instruction address breakpoint register
IBAT	Instruction BAT
ICMP	Instruction TLB compare
IEEE	Institute for Electrical and Electronics Engineers
Int Ack	Interrupt acknowledge
IMISS	Instruction TLB miss address
IQ	Instruction queue
ISA	Industry standard architecture
ITLB	Instruction translation lookaside buffer
IU	Integer unit
JTAG	Joint test action group interface
L2	Secondary cache
LIFO	Last-in-first-out
LR	Link register
LRU	Least recently
LSB	Least-significant byte
lsb	Least-significant bit
LSU	Load/store unit
MICR	Memory interface configuration register
MCCR	Memory control configuration register
MEI	Modified/exclusive/invalid
MESI	Modified/exclusive/shared/invalid—cache coherency protocol
MMU	Memory management unit
MSB	Most-significant byte
msb	Most-significant bit

Table i. Acronyms and Abbreviated Terms (continued)

Term	Meaning
MSR	Machine state register
Mux	Multiplex
NaN	Not a number
No-op	No operation
OEA	Operating environment architecture
PCI	Peripheral component interconnect
PCIB/MC	PCI bridge/memory controller
PICR	Processor interface configuration register
PID	Processor identification tag
PIR	Processor identification register
PLL	Phase-locked loop
PMC	Power management controller
PMCR	Power management configuration register
PTE	Page table entry
PTEG	Page table entry group
PVR	Processor version register
RAS	Row address strobe
RAW	Read-after-write
RISC	Reduced instruction set computing
ROM	Read-only memory
RPA	Required physical address
RTL	Register transfer language
RWITM	Read with intent to modify
SDR1	Register that specifies the page table base address for virtual-to-physical address translation
SDRAM	Synchronous dynamic random access memory
SIMM	Single in-line memory module
SPR	Special-purpose register
SR	Segment register
SRR0	Machine status save/restore register 0
SRR1	Machine status save/restore register 1
SRU	System register unit
TAP	Test access port
TB	Time base facility

Table i. Acronyms and Abbreviated Terms (continued)

Term	Meaning
TBL	Time base lower register
TBU	Time base upper register
TLB	Translation lookaside buffer
TTL	Transistor-to-transistor logic
UIMM	Unsigned immediate value
UISA	User instruction set architecture
UUT	Unit under test
VCO	Voltage-controlled oscillator
VEA	Virtual environment architecture
WAR	Write-after-read
WAW	Write-after-write
WIMG	Write-through/caching-inhibited/memory-coherency enforced/guarded bits
XER	Register for indicating conditions such as carries and overflows for integer operations

Chapter 1
Overview

The primary objective of this manual is to describe the functionality of the MPC8245 and the MPC8241 PowerPC™ integrated processors. This chapter provides an overview of the MPC8245 PowerPC integrated processor for high-performance embedded systems. The MPC8245 is a cost-effective, general-purpose integrated processor for applications using PCI in networking infrastructure, telecommunications, and other embedded markets. It can be used for control processing in applications such as network routers and switches, mass storage subsystems, network appliances, and print and imaging systems.

To locate any published errata or updates for this document, refer to the web site at http://www.motorola.com/semiconductors.

1.1 MPC8245 Integrated Processor Overview

The MPC8245 is comprised of a peripheral logic block and a 32-bit superscalar processor core, as shown in Figure 1-1.

The peripheral logic integrates the following components:

- PCI bridge
- Dual universal asynchronous receiver/transmitter (DUART)
- Memory controller
- DMA controller
- PIC unit
- Message unit (and I_2O interface)
- I^2C controller

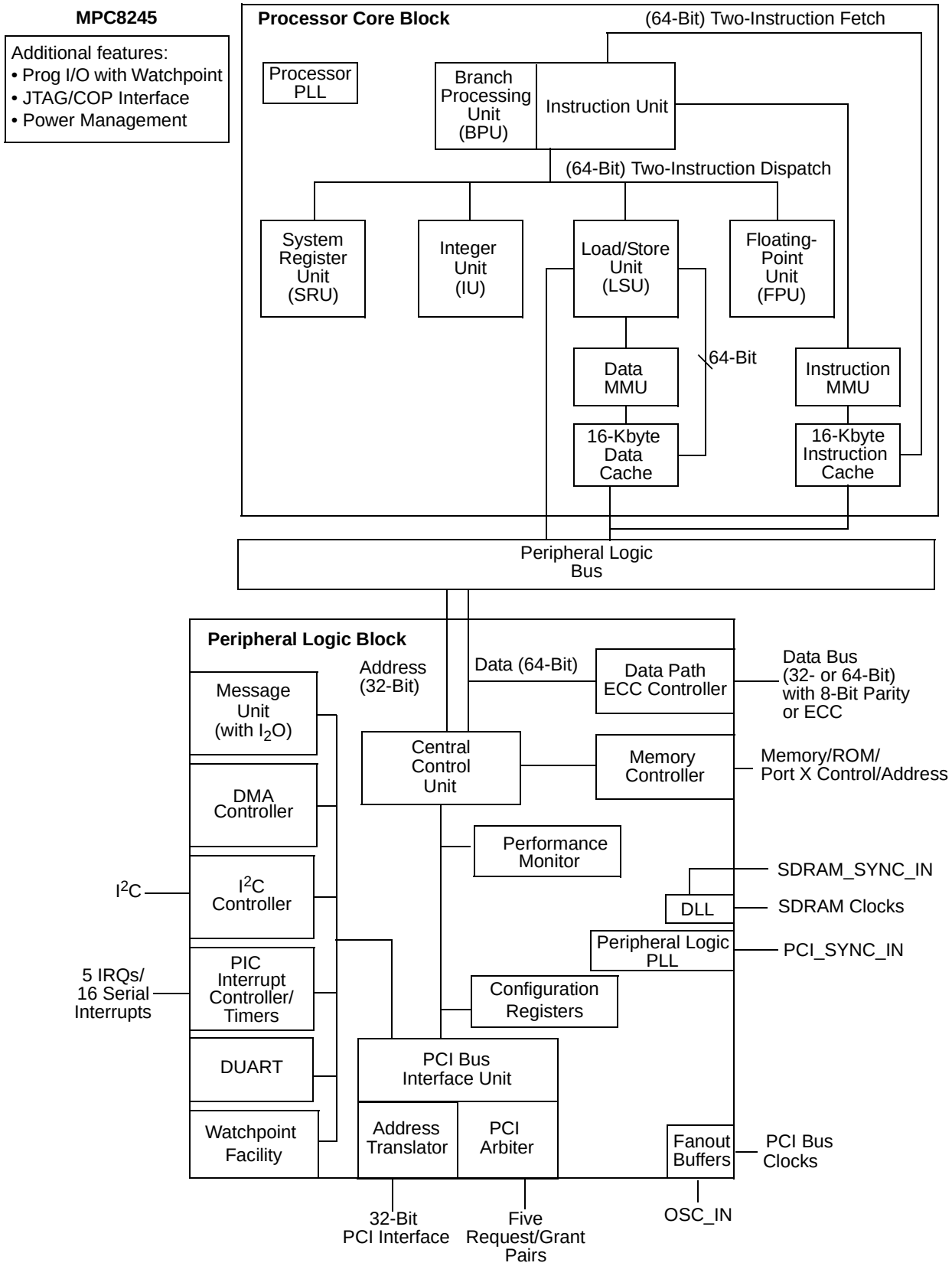


Figure 1-1. MPC8245 Integrated Processor Functional Block Diagram

The processor core is a full-featured, high-performance processor with the following features:

- Floating-point support
- Memory management
- 16-Kbyte instruction cache
- 16-Kbyte data cache
- Power management features

The integration reduces the overall packaging requirements and the number of discrete devices required for an embedded system.

The MPC8245 contains an internal peripheral logic bus that interfaces the processor core to the peripheral logic. The core can operate at a variety of frequencies, allowing the designer to trade off performance for power consumption. The processor core is clocked from a separate PLL that is referenced to the peripheral logic PLL to allow the microprocessor and peripheral logic block to operate at different frequencies while maintaining a synchronous bus interface. The interface uses a 64- or 32-bit data bus (depending on memory data bus width) and a 32-bit address bus along with control signals that enable the interface between the processor and peripheral logic to be optimized for performance. PCI accesses to the MPC8245 memory space are passed to the processor bus for snooping when snoop mode is enabled.

The processor core and peripheral logic serve general purposes for a variety of embedded applications. The MPC8245 can be used as either a PCI host or PCI agent controller.

1.1.1 MPC8245 Integrated Processor Features

This section summarizes the features of the MPC8245. Major features are as follows:

- Processor core
  - — High-performance, superscalar processor core
  - — Integer unit (IU), floating-point unit (FPU) (software enabled or disabled), load/store unit (LSU), system register unit (SRU), and a branch processing unit (BPU)
  - — 16-Kbyte instruction cache
  - — 16-Kbyte data cache
  - — Lockable L1 caches—entire cache or on a per-way basis up to three of four ways
  - — Dynamic power management that supports 60x nap, doze, and sleep modes
- Peripheral logic
  - — Peripheral logic bus
    - – Supports various operating frequencies and bus divider ratios
    - – 32-bit address bus, 64-bit data bus
    - – Supports full memory coherency
    - – Decoupled address and data buses for pipelining of peripheral logic bus accesses
    - – Store gathering on peripheral logic bus-to-PCI writes
  - — Memory interface
    - – Supports up to 2 Gbytes of SDRAM memory
    - – High-bandwidth data bus (32- or 64-bit) to SDRAM
    - – Programmable timing supporting SDRAM
    - – Supports one to eight banks of 16-, 64-, 128-, 256-, or 512-Mbit memory devices
    - – Write-buffering for PCI and processor accesses
    - – Supports normal parity, read-modify-write (RMW), or ECC
    - – Data-path buffering between memory interface and processor
    - – Low-voltage TTL logic (LVTTL) interfaces
    - – 272 Mbytes of base and extended ROM/Flash/Port X space
    - – Base ROM space supports 8-bit data path or same size as the SDRAM data path (32- or 64-bit)
    - – Extended ROM space supports 8-, 16-, 32-bit gathering data path, 32- or 64-bit (wide) data path

  - Port X: 8-, 16-, 32-, or 64-bit general-purpose I/O port using ROM controller interface with programmable address strobe timing, data-ready input signal ($\overline{\text{DRDY}}$), and four chip selects

— 32-bit PCI interface
  - Operates up to 66 MHz
  - PCI 2.2-compliant
  - PCI 5.0-V tolerance
  - Support for dual address cycle (DAC) for 64-bit PCI addressing (master only)
  - Support for PCI locked accesses to memory
  - Support for accesses to PCI memory, I/O, and configuration spaces
  - Selectable big- or little-endian operation
  - Store gathering of processor-to-PCI write and PCI-to-memory write accesses
  - Memory prefetching of PCI read accesses
  - Selectable hardware-enforced coherency
  - PCI bus arbitration unit (five request or grant pairs)
  - PCI agent mode capability
  - Address translation with two inbound and outbound units (ATU)
  - Some internal configuration registers accessible from PCI

— Two-channel integrated DMA controller. (Writes to ROM/Port X are not supported.)
  - Supports direct mode or chaining mode (automatic linking of DMA transfers)
  - Supports scatter gathering—read or write discontinuous memory
  - 64 byte-per-channel transfer queue
  - Interrupt on completed segment, chain, and error
  - Local-to-local memory
  - PCI-to-PCI memory
  - Local-to-PCI memory
  - PCI memory-to-local memory

— Message unit
  - Two doorbell registers
  - Two inbound and two outbound messaging registers
  - I_2O message interface

— I^2C controller with full master/slave support that accepts broadcast messages

— Programmable interrupt controller (PIC)
  - Five hardware interrupts (IRQs) or 16 serial interrupts

  - Four programmable timers with cascade
- Two (dual) universal asynchronous receiver/transmitters (UARTs)
- Integrated PCI bus and SDRAM clock generation
- Programmable PCI bus and memory interface output drivers

- System-level performance monitor facility
- Debug features
  - Memory attribute and PCI attribute signals
  - Debug address signals
  - $\overline{\text{MIV}}$ signal marks valid address and data bus cycles on the memory bus.
  - Programmable input and output signals with watchpoint capability
  - Error injection/capture on data path
  - IEEE 1149.1 (JTAG)/test interface

1.1.2 MPC8245 Integrated Processor Applications

The MPC8245 can be used for control processing in applications such as the following:

- Routers
- Switches
- Multi-channel modems
- Network storage
- Image display systems
- Enterprise I/O processor
- Internet access device (IAD)
- Disk controller for RAID systems
- Copier or printer-board control

Figure 1-2 shows the MPC8245 in the role of host processor.

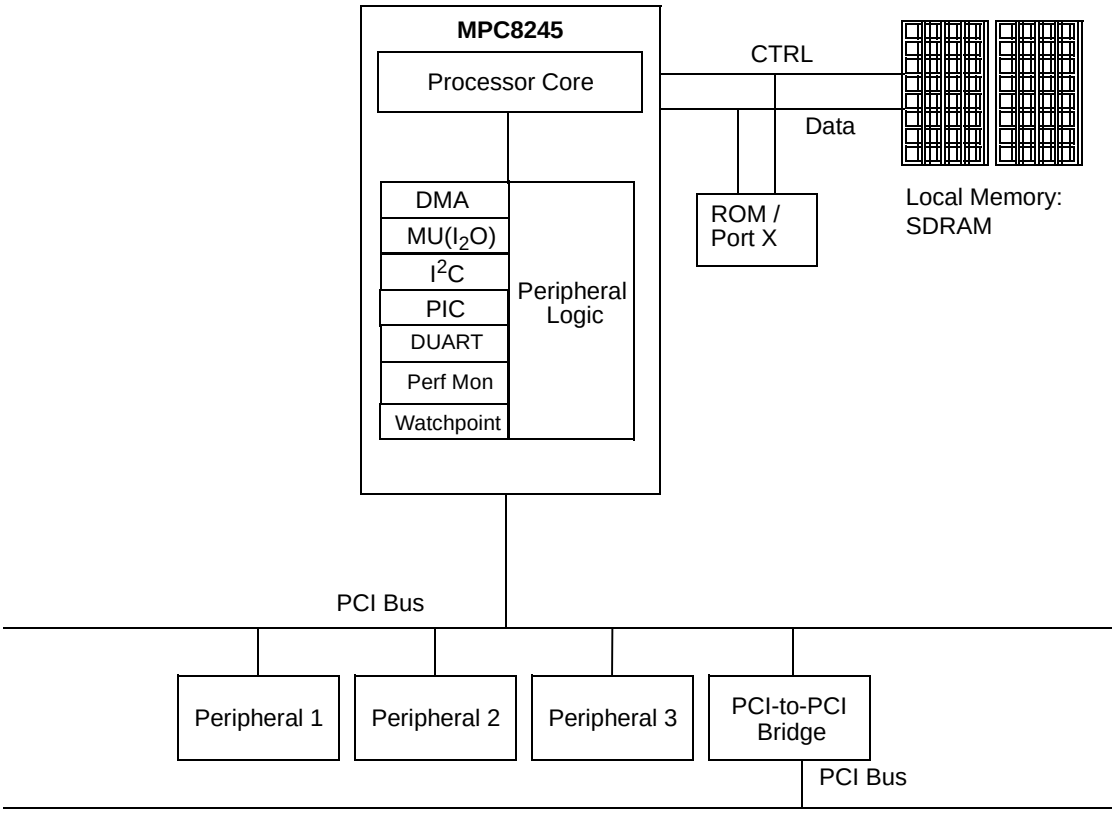


Figure 1-2. System Using MPC8245 as a Host Processor

Figure 1-3 shows the MPC8245 in a peripheral processor application.

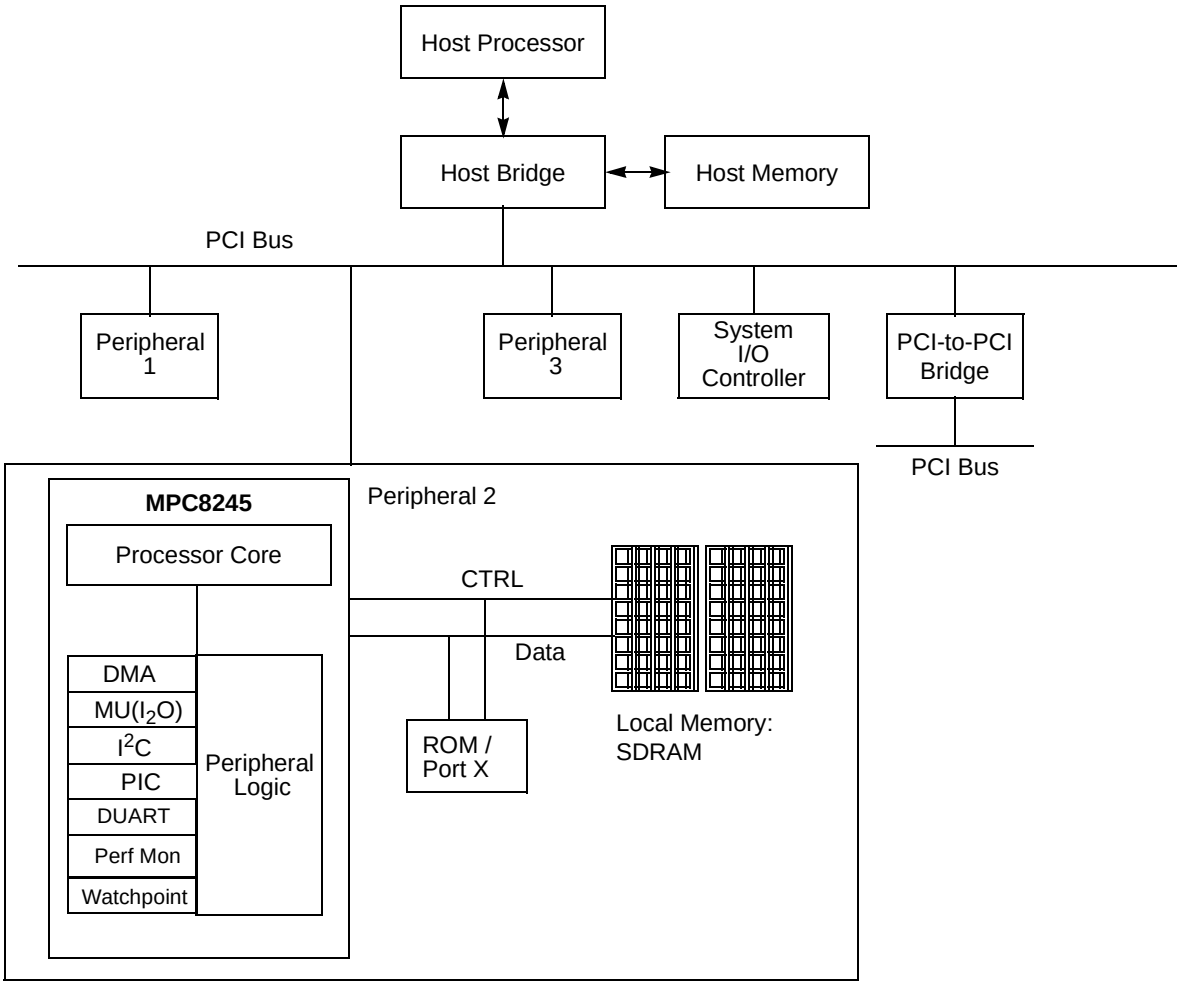


Figure 1-3. Embedded System Using an MPC8245 as a Peripheral Processor

Figure 1-4 shows the MPC8245 as a distributed I/O processing device. In this figure, the PCI-to-PCI bridge could be the PCI type 0 variety. The MPC8245 would not be part of the system configuration map. This configuration is useful in applications such as RAID controllers, where the I/O devices shown are SCSI controllers, or multi-port network controllers where the devices shown are Ethernet controllers.

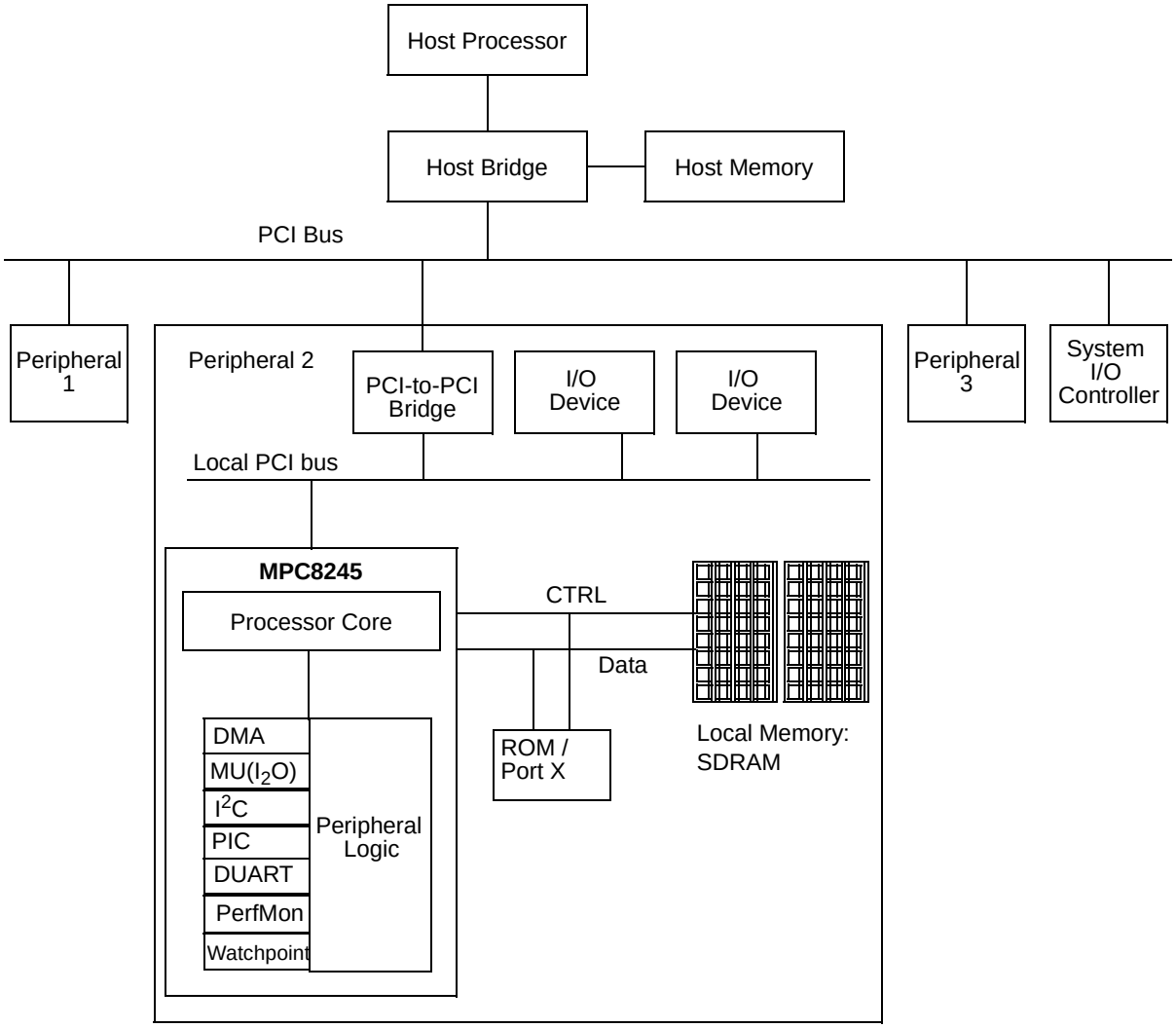


Figure 1-4. Embedded System Using an MPC8245 as a Distributed Processor

1.2 Processor Core Overview

The MPC8245 contains an embedded version of the MPC603e processor (G2 processor core). For detailed information regarding the processor, refer to the following two manuals:

- *MPC603e RISC Microprocessor User's Manual* (those chapters that describe the programming model, cache model, memory management model, exception model, and instruction timing)

- *Programming Environments Manual for 32-Bit Implementations of the PowerPC Architecture*

This section presents an overview of the processor core, provides a block diagram showing the major functional units, and describes briefly how those units interact. For more information, refer to Chapter 5, “G2 Processor Core” and the *G2 PowerPC™ Core Reference Manual.*

The processor core is a low-power implementation of the family of microprocessors that implement the PowerPC architecture. The processor core implements the 32-bit portion of the PowerPC architecture, which provides 32-bit effective addresses, integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits.

The processor core is a superscalar processor that can issue and retire as many as three instructions per clock. Instructions can execute out of order for increased performance. However, the processor core makes completion appear sequential.

1.2.1 Execution Units

The processor core integrates five execution units—an integer unit (IU), a floating-point unit (FPU), a branch processing unit (BPU), a load/store unit (LSU), and a system register unit (SRU). The ability to execute five instructions in parallel and the use of simple instructions with rapid execution times yield high efficiency and throughput. Most integer instructions execute in one clock cycle. On the processor core, the FPU is pipelined so a single-precision multiply-add instruction can be issued and completed every clock cycle.

Figure 1-5 on page 1-11 provides a block diagram of the MPC8245 processor core that shows how the execution units (IU, FPU, BPU, LSU, and SRU) operate independently and in parallel.

NOTE

The conceptual diagram in Figure 1-5 does not attempt to show the physical implementation of these features on the chip.

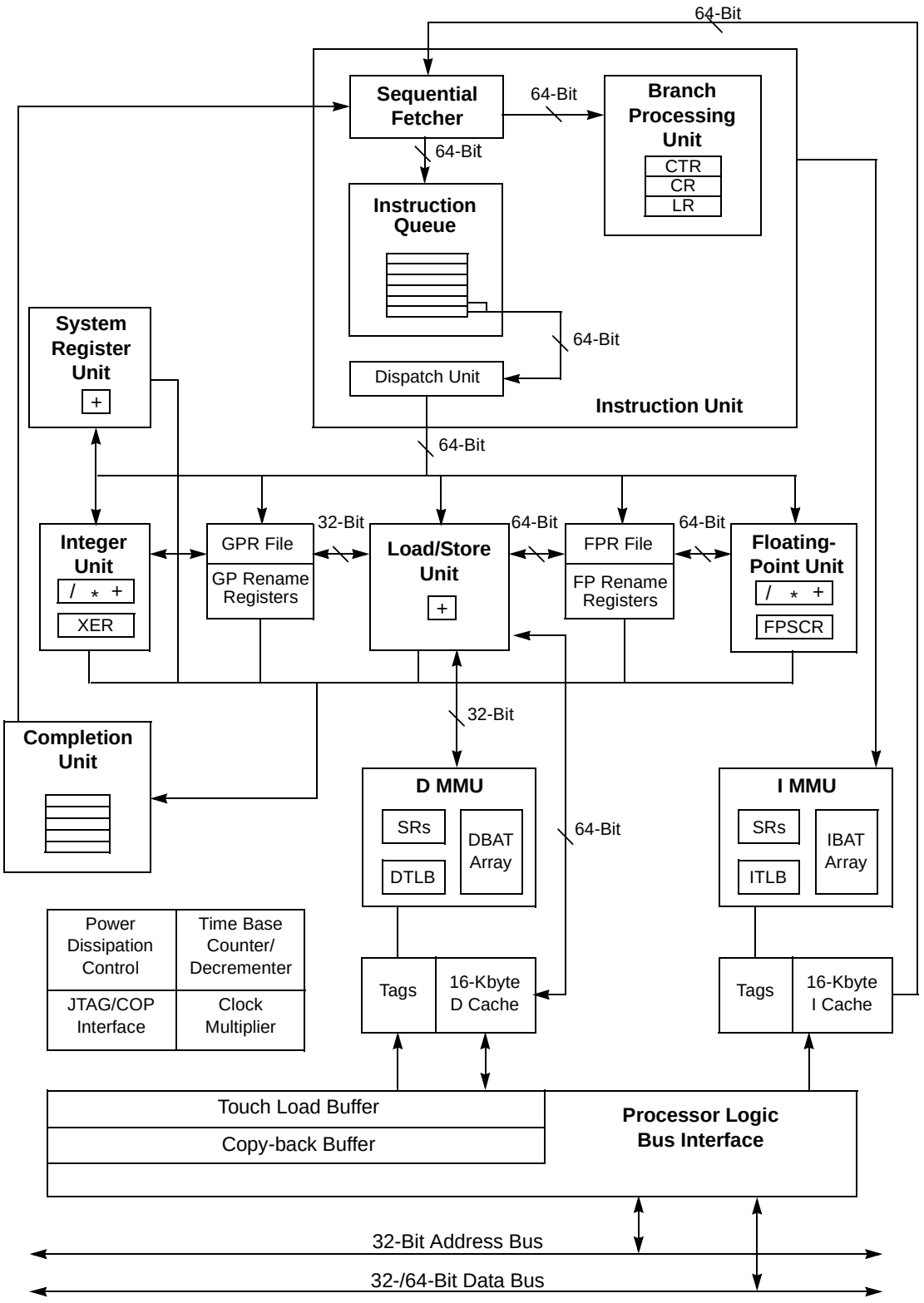


Figure 1-5. MPC8245 Integrated Processor Core Block Diagram

1.2.2 Data Types

The processor core supports integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits.

1.2.3 Caching

The processor core provides independent on-chip, 16-Kbyte, four-way set-associative, physically-addressed instruction and data caches. The processor also features independent on-chip instruction and data memory management units (MMUs). The MMUs contain 64-entry, two-way set-associative, data and instruction translation lookaside buffers (DTLB and ITLB) that provide support for demand-paged virtual memory address translation and variable-sized block translation. The TLBs and caches use a least recently used (LRU) replacement algorithm. The processor also supports block address translation through the use of two independent instruction and data block address translation (IBAT and DBAT) arrays of four entries each. Effective addresses are compared simultaneously with all four entries in the BAT array during block translation. In accordance with the PowerPC architecture, if an effective address hits in both the TLB and BAT array, the BAT translation takes priority.

As an added feature to the processor core, the MPC8245 can lock the contents of one to three ways in the instruction and data cache (or an entire cache). For example, embedded applications can lock interrupt routines or other important (time-sensitive) instruction sequences into the instruction cache, and data can be locked into the data cache, which may be important to code that must have deterministic execution.

1.2.4 Bus Operation

The processor core has a selectable 32- or 64-bit data bus and a 32-bit address bus. The processor core supports single-beat and burst data transfers for memory accesses and also supports memory-mapped I/O operations.

1.3 Peripheral Logic Bus

The MPC8245 contains an internal peripheral logic bus that interfaces the processor core to the peripheral logic. The core can operate at a variety of frequencies, which allows the designer to balance performance and power consumption. The processor core is clocked from a separate PLL that is referenced to the peripheral logic PLL. This setup allows the microprocessor and the peripheral logic to operate at different frequencies while maintaining a synchronous bus interface.

The processor core-to-peripheral logic interface includes a 32-bit address bus, a 32- or 64-bit data bus and control and information signals. The peripheral logic bus allows for

internal address-only transactions as well as address and data transactions. The processor core control and information signals include the following:

- Address arbitration, start, transfer, and termination
- Transfer attribute
- Data arbitration, transfer, and termination
- Processor state signals

Test and control signals provide diagnostics for selected internal circuits.

The peripheral logic interface supports bus pipelining, which allows the address tenure of one transaction to overlap the data tenure of another. PCI accesses to the memory space are monitored by the peripheral logic bus to allow the processor to snoop these accesses (when snooping is not explicitly disabled).

As part of the peripheral logic bus interface, the processor core's data bus is configured at power-on to either a 32- or 64-bit width. When the processor is configured with a 32-bit data bus, memory accesses on the peripheral logic bus interface allow transfer sizes of 8, 16, 24, or 32 bits in 1 bus clock cycle. Data transfers occur in either single-beat transactions, or two- or eight-beat burst transactions, with a single-beat transaction transferring as many as 32 bits. Single- or double-beat transactions are caused by noncached accesses that access memory directly (that is, reading and writing when caching is disabled, caching-inhibited accesses, and storing in write-through mode). Eight-beat burst transactions, which always transfer an entire cache line (32 bytes), are initiated when a line is read from or written to memory.

When the peripheral logic bus interface is configured with a 64-bit data bus, memory accesses allow transfer sizes of 8, 16, 24, 32, or 64 bits in one bus clock cycle. Data transfers occur in either single-beat transactions or four-beat burst transactions. Single-beat transactions occur because noncached accesses access memory directly (that is, reads and writes when caching is disabled, caching-inhibited accesses, and stores in write-through mode). Four-beat burst transactions, which always transfer an entire cache line (32 bytes), are initiated when a block is read from or written to memory.

1.4 Peripheral Logic Overview

Integration reduces the overall packaging requirements and the number of discrete devices that an embedded system requires.The peripheral logic block integrates the following elements:

- PCI bridge
- Memory controller
- DMA controller
- PIC interrupt controller/timers
- Message unit with an intelligent input/output (I_2O) message interface
- Inter-integrated circuit (I^2C) controller
- Dual universal asynchronous receiver/transmitter (DUART)
- Performance monitor
- Watchpoint facility

Figure 1-6 shows the major functional units within the peripheral logic block. Note that this conceptual block diagram shows basic features rather than physical implementation.

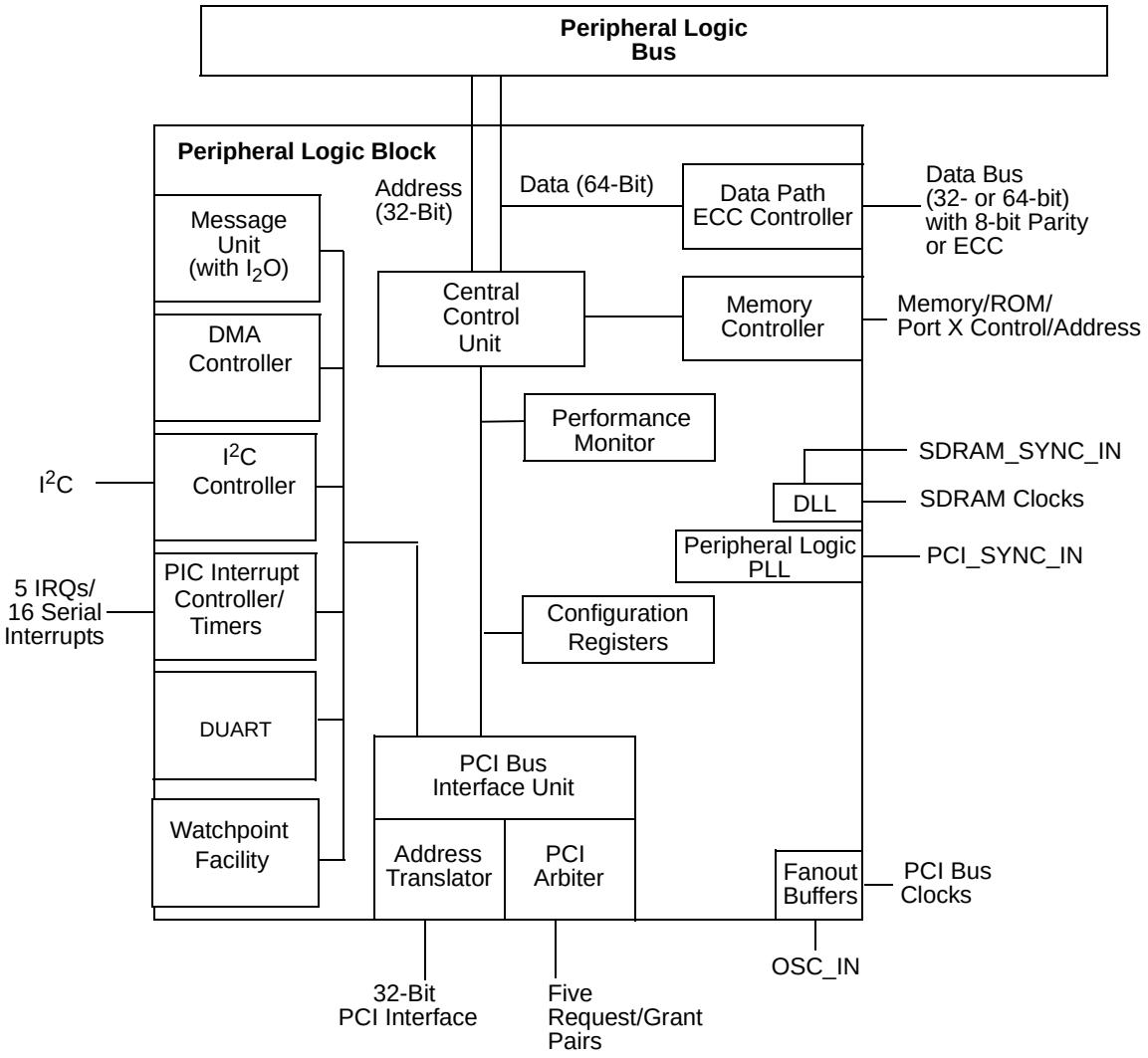


Figure 1-6. MPC8245 Peripheral Logic Block Diagram

1.4.1 Memory System Interface

The MPC8245 memory interface controls processor and PCI interactions to main memory and supports a variety of flash or ROM configurations. The MPC8245 supports synchronous DRAM (SDRAM). The maximum supported memory size is two Gbytes of SDRAM and 272 Mbytes of ROM/Flash. SDRAM must comply with the JEDEC SDRAM specification.

The MPC8245 is designed to control a 32- or 64-bit data path to main memory SDRAM. For a 32-bit data path, the MPC8245 can be configured to check and generate byte parity using four parity bits. For a 64-bit data path, the MPC8245 can be configured to support

parity or ECC checking and generation with eight parity/syndrome bits checked and generated. Note that the data bus width (32- or 64-bit) chosen at reset for the 60x bus interface is also used for the memory interface.

The MPC8245 supports SDRAM bank sizes from 1 to 512 Mbytes and provides bank start address and end address configuration registers. Note that the MPC8245 does not support DRAM. The MPC8245 can be configured so that appropriate row and column address multiplexing occurs according to the accessed memory bank. Addresses are provided to SDRAM through a 14-bit interface.

The ROM/Flash interface of the MPC8245 controls two areas of memory. These areas are base ROM space, which is a 16-Mbyte area, and extended ROM space, which is a 256-Mbyte area. Four chip selects, one write enable, one output enable, and up to 25 address signals are provided for ROM/Flash systems.

The MPC8245 implements Port X, a memory bus interface that facilitates the connection of general-purpose I/O devices. The Port X functionality allows the designer to connect external registers, communication devices, and other such devices directly to the MPC8245. Some devices may require a small amount of external logic to generate address strobes, chip selects, and other signals properly.

1.4.2 Peripheral Component Interconnect (PCI) Interface

The PCI interface of the MPC8245 provides mode-selectable, big- to little-endian conversion and can operate at speeds up to 66 MHz.

MPC8245 implements the following PCI bus commands:

- Memory, I/O
- Configuration reads and writes and special cycle
- Interrupt acknowledge
- Dual-address cycle
- Other initiator-caused commands

The PCI interface for the MPC8245 is compliant with the *Peripheral Component Interconnect Specification,* Rev. 2.2, and includes the following:

- PCI agent capability
- PCI bus arbitration unit
- Address maps and translation
- Big- and little-endian modes
- PCI bus clock buffers and bus ratios

1.4.2.1 PCI Agent Capability

The MPC8245 PCI interface can be configured as host or agent. In host mode, the interface acts as the main memory controller for the system and responds to all host memory transactions.

In certain applications, the embedded system architecture mandates that the MPC8245 should act as a peripheral processor. In that case, the peripheral logic must not act like a host bridge for the PCI bus. Instead, it functions as a configurable device that a host bridge accesses. This capability allows multiple MPC8245 devices to coexist with other PCI peripheral devices on a single PCI bus. The MPC8245 has PCI 2.2-compliant configuration capabilities.

In agent mode, the MPC8245 can be configured to respond to a programmed window of PCI memory space. A variety of initialization modes can boot the device.

1.4.2.2 PCI Bus Arbitration Unit

The MPC8245 contains a PCI bus arbitration unit that eliminates the need for an external unit, which cuts system complexity and cost. This unit has the following features:

- Five external arbitration signal pairs. The MPC8245 is the sixth member of the arbitration pool.
- The bus arbitration unit allows fairness as well as a priority mechanism.
- A two-level round-robin scheme is used, in which each device can be programmed within a pool of a high- or low-priority arbitration. One member of the low-priority pool is promoted to the high-priority pool. As soon as it is granted the bus, it returns to the low-priority pool.
- The unit can be disabled to allow a remote arbitration unit to be used.

1.4.2.3 Address Maps and Translation

The MPC8245 processor bus supports memory-mapped accesses. The address space is divided between memory and PCI according to address map B.

The MPC8245 allows remapping of PCI to local memory (inbound) transactions and processor core to PCI (outbound) transactions. Agent mode supports both inbound and outbound translation. Host mode supports only outbound translation. Note that address translation is supported only in address map B because agent mode is supported for address map B only.

When the MPC8245 is configured as a PCI agent, the amount of local memory that is visible to the system is programmable. In addition, it may be necessary to map the local memory to a different system memory address space. The address translation unit handles the mapping of both inbound and outbound transactions for these cases.

1.4.2.4 Byte Ordering

The MPC8245 allows the processor to run in either big- or little-endian mode (except for the initial boot code, which must run in big-endian mode).

1.4.2.5 Bus Clock Buffers and Bus Ratios

Refer to Section 1.4.8, “Integrated PCI Bus and SDRAM Clock Generation” for information on clock buffers and ratios in the MPC8245.

1.4.3 DMA Controller

The integrated DMA controller contains two independent units. Note that the DMA writing capability for local memory is available for SDRAM, but writing is not available for the ROM/Port X interface. Each DMA unit is capable of performing the following types of transfers:

- PCI-to-local memory
- Local-to-PCI memory
- PCI-to-PCI memory
- Local-to-local memory

The DMA controller allows chaining through local memory-mapped chain descriptors. Transfers can be scatter-gathered and misaligned. Interrupts are provided on completed segment, chain, and error conditions. PCI dual address cycle (DAC) support is provided.

1.4.4 Message Unit (MU)

Many embedded applications require handshake algorithms to pass control, status, and data information from one owner to another. The handshake algorithm is made easier through the doorbell and message registers. The MPC8245 has a message unit (MU) that implements doorbell and message registers as well as an I_2O interface. The MU has many conditions that can cause interrupts, and it routes external interrupts to the PCI interface and internal interrupts through PIC to the processor core.

1.4.4.1 Doorbell Registers

The MPC8245 MU contains one 32-bit inbound doorbell register and one 32-bit outbound doorbell register. The inbound doorbell register allows a remote processor to set a bit in the register from the PCI bus, and an interrupt to the processor core is generated. Only the processor core can clear the inbound doorbell register bits.

The processor core can write to the outbound register, causing the outbound interrupt signal $\overline{\text{INTA}}$ to assert and interrupting the host processor. When $\overline{\text{INTA}}$ is generated, only the host

processor can clear it. The host processor writes ones to the bits that are set in the outbound doorbell register.

1.4.4.2 Inbound and Outbound Message Registers

The MPC8245 contains two 32-bit inbound message registers and two 32-bit outbound message registers. The inbound registers allow a remote host or PCI master to write a 32-bit value, causing an interrupt to the processor core. The outbound registers allow the processor core to write an outbound message that causes the outbound interrupt signal $\overline{\text{INTA}}$ to assert.

1.4.4.3 Intelligent Input/Output Controller (I_2O)

The intelligent I/O specification is an open standard that defines an abstraction layer interface between the OS and subsystem drivers. Messages are passed between the message abstraction layer from one device to another.

The I_2O specification describes a system comprised of host processors and input/output platforms (IOPs). The host processor is a single processor or a collection of processors working together to execute a homogenous operating system. An IOP consists of a processor, memory, and I/O interfaces. The IOP functions separately from other processors within the system to handle system I/O functions.

The I_2O controller of the MU enhances communication between hosts and IOPs within a system. The two paths for messages are as follows:

- An inbound queue transfers messages from a remote host or IOP to the processor core.
- An outbound queue transfers messages from the processor core to the remote host.

Each queue is implemented as a pair of FIFOs. The inbound and outbound message queues each consist of a free_list FIFO and a post_list FIFO.

Messages are transferred between the host and the IOP using PCI memory-mapped registers. The MPC8245 I_2O controller facilitates moving the messages to and from the inbound and outbound registers and local IOP memory. Interrupts signal the host and IOP to indicate the arrival of new messages.

1.4.5 Inter-Integrated Circuit (I^2C) Controller

The I^2C serial interface has become an industry de facto standard for communicating with low-speed peripherals, and is typically used for system management functions and EEPROM support. The MPC8245 contains an I^2C controller with full master and slave functionality.

1.4.6 Programmable Interrupt Controller (PIC)

The integrated programmable interrupt controller (PIC) of the MPC8245 reduces the overall component count in embedded applications. The PIC unit collects external and internal hardware interrupts, prioritizes them, and delivers them to the processor core.

The module operates in one of three modes:

- In direct mode, five level- or edge-triggered interrupts can be connected directly to an MPC8245.
- In pass-through mode, interrupts detected at the IRQ0 input are passed directly to the processor core. Also in this case, interrupts generated by the I_2O, I^2C, DMA, controllers, watchpoint monitor, doorbell and message registers, and DUART are passed to the $\overline{\text{L_INT}}$ output signal.
- The MPC8245 provides a serial delivery mechanism when more than five external interrupt sources are needed. The serial mechanism allows for up to 16 interrupts to be serially scanned into the MPC8245. This mechanism increases the number of interrupts without increasing the number of pins but with increasing the interrupt latency.

The outbound interrupt request signal, $\overline{\text{L_INT}}$, signals interrupts to the host processor when the MPC8245 is configured for agent mode. The MPC8245 PIC includes four programmable timers that can be used for system timing or for generating periodic interrupts.

1.4.7 Dual Universal Asynchronous Receiver/Transmitter (DUART)

The MPC8245 DUART controls the processor core interface to the serial devices attached to the UART signals. Each UART is capable of converting the parallel data from the processor core into a single serial bit stream for outbound transmission. On inbound transmission, the UART converts the serial bit stream into the bytes for handling by the processor core.

Some of the features of the MPC8245 DUART unit include:

- Full-duplex operation
- Program model compatible with the original 16450 UART and the PC16550D an improved version of the 16450 that can be put into an alternate mode (FIFO mode)
- 16450 register reset values
- FIFO mode for both transmitter and receiver provide 16-byte FIFOs
- Serial data encapsulation and decapsulation with standard asynchronous communication bits (START, STOP, and parity)
- Maskable transmit, receive, line status, and MODEM status interrupts

- Software-programmable baud generators divide SDRAM_CLK*n* by 1 to ($2^{16} - 1$) and generate a 16x clock
- Clear to send ($\overline{\text{CTS}}$) and ready to send ($\overline{\text{RTS}}$) MODEM control functions
- Software-selectable serial-interface data format (data length, parity, 1/1.5/2 STOP bit, baud rate)

1.4.8 Integrated PCI Bus and SDRAM Clock Generation

Two PCI bus clocking solutions are directed towards a wide range of operating frequencies with different system configurations and requirements. Trade-offs between operating frequency (for performance) and power consumption are easily managed. For systems where the MPC8245 is the host controller with a minimum number of clock loads, five clock fanout buffers are provided on-chip.

For systems requiring more clock fanout or where the MPC8245 is an agent device, external clock buffers may be used.

The MPC8245 provides an on-chip delay-locked loop (DLL) that supplies the external memory bus clock signals to SDRAM banks. The memory bus clock signals are the same frequency and are synchronous with the internal peripheral bus clock.

The internal DLL generated the four SDRAM clock outputs, and can account for the trace length between the SDRAM_SYNC_OUT signal and SDRAM_SYNC_IN signal.

The MPC8245 requires a single clock input signal, PCI_SYNC_IN, which the PCI clock fanout buffers can drive (specifically, the PCI_SYNC_OUT output). An external clock driver can also drive PCI_SYNC_IN.

The PCI bus frequency drives PCI_SYNC_IN. An internal PLL, using PCI_SYNC_IN as a reference, generates an internal *sys-logic-clk* signal that is used for the internal logic. The peripheral bus clock frequency is configured at reset (by the MPC8245 PLL configuration signals PLL_CFG[0:4]) to be a multiple of the PCI_SYNC_IN frequency.

The internal clocking of the processor core is generated from and synchronized to the internal peripheral bus clock by means of a second PLL. The core's PLL provides multiples of the internal processor core clock rates as specified in the *MPC8245 Integrated Processor Hardware Specifications.*

1.4.9 Performance Monitor

The MPC8245 core logic contains a performance facility that monitors bridge logic events such as SDRAM or PCI bus traffic, DUART, or a number of interrupts emanating from an interrupt controller. The performance monitor can be used for the following purposes:

- To optimize overall system performance by monitoring bridge logic events

- To understand the MPC8245 behavior in any system or software environment, because some systems or software environments are not easily characterized by signal traces or benchmarks
- To help system developers bring up and debug their systems

The performance monitor uses the following run-time registers in the embedded utility memory block:

- Performance monitor counter registers (PMC0–PMC3) are 32-bit counters that count occurrences of a software-selectable event.
- Command registers (CMDR0–CMDR3) that select the counter, type of event, event to be counted, and threshold for that event
- Monitor mode control register (MMCR) that controls the operation of the performance monitor counters

1.5 Power Management

The MPC8245 provides both automatic and program-controllable power reduction modes for progressive reduction of power consumption.

The MPC8245 has independent power management functionality for both the processor core and the peripheral logic. The MPC8245 provides hardware support for three levels of programmable power reduction for both the processor and the peripheral logic. Register programming invokes doze, nap, and sleep modes —HID0 in the case of the processor core and configuration registers in the case of the peripheral logic block.

The processor and peripheral logic blocks are both fully static, allowing internal logic states to be preserved during all power-saving modes. The following sections describe the programmable power modes.

1.5.1 Programmable Processor Power Management Modes

Table 1-1 summarizes the programmable power-saving modes for the processor core. These modes are very similar to those in the MPC603e device.

Table 1-1. Peripheral Logic Power Modes Summary

PM Mode	Functioning Units	Activation Method	Full-Power Wake Up Method
Full power	All units active	—	—
Full power (with DPM)	Requested logic by demand	By instruction dispatch	—
Doze	Bus snooping Data cache as needed Decrementer timer	Controlled by software (write to HID0)	External asynchronous exceptions (assertion of $\overline{\text{SMI}}$ or $\overline{int}$) Decrementer exception Hard or soft reset Machine check exception ($\overline{mcp}$)

Table 1-1. Peripheral Logic Power Modes Summary (continued)

PM Mode	Functioning Units	Activation Method	Full-Power Wake Up Method
Nap	Decrementer timer	Controlled by software (write to HID0) and qualified with QACK from peripheral logic	External asynchronous exceptions (assertion of SMI or *int*) Decrementer exception Negation of QACK by peripheral logic Hard or soft reset Machine check exception (*mcp*)
Sleep	None	Controlled by software (write to HID0) and qualified with QACK from peripheral logic	External asynchronous exceptions (assertion of SMI or *int*) Negation of QACK by peripheral logic Hard or soft reset Machine check exception (*mcp*)

1.5.2 Programmable Peripheral Logic Power Management Modes

The following sections describe the power management modes of the peripheral logic. Table 1-2 summarizes the programmable power-saving modes for the peripheral logic block.

Table 1-2. Programmable Peripheral Logic Power Modes Summary

PM Mode	Functioning Units	Activation Method	Full-Power Wake Up Method
Full power	All units active	—	—
Doze	PCI address decoding and bus arbiter System RAM refreshing Processor bus request and NMI monitoring PIC unit I^2C unit PLL	Controlled by software (write to PMCR1)	PCI access to memory Processor bus request Assertion of NMI [1] Interrupt to PIC Hard reset
Nap	PCI address decoding and bus arbiter System RAM refreshing Processor bus request and NMI monitoring PIC unit I^2C unit PLL	Controlled by software (write to PMCR1) and processor core in nap or sleep mode (QREQ asserted)	PCI access to memory [2] Processor bus request Assertion of NMInterrupt to PIC Hard reset
Sleep	PCI bus arbiter System RAM refreshing (can be disabled) Processor bus request and NMI monitoring PIC unit I^2C unit PLL (can be disabled)	Controlled by software (write to PMCR1) and processor core in nap or sleep mode (QREQ asserted)	Processor bus request Assertion of NMI[1] Interrupt to PIC Hard reset

1 Programmable option based on value of PICR1[MCP_EN] = 1.

2 A PCI access to memory in nap mode does not cause QACK to negate. Consequently, it does not wake up the processor core, and the processor core does not snoop this access. After servicing the PCI access, the peripheral logic automatically returns to the nap mode.

1.6 Programmable I/O Signals with Watchpoint

The MPC8245 programmable I/O facility allows the system designer to monitor the peripheral logic bus. One or two watchpoints and their respective 4-bit countdown values can be programmed. When the programmed threshold of the selected watchpoint is reached, an external trigger signal is generated and the states of the peripheral logic address, control, and data buses are latched into user-readable registers.

1.7 Debug Features

The MPC8245 includes the following debug features:

- Memory attribute and PCI attribute signals
- Debug address signals
- $\overline{\text{MIV}}$ signal that marks valid address and data bus cycles on the memory bus
- Error injection and capture on data path
- IEEE 1149.1 (JTAG)/test interface

1.7.1 Memory Attribute and PCI Attribute Signals

The MPC8245 provides additional information corresponding to memory and PCI activity on several signals to assist with system debugging. The two types of attribute signals are described as follows:

- Memory attribute signals are associated with the memory interface and provide information about the source of the memory operation that MPC8245 is performing.
- The PCI attribute signals are associated with the PCI interface and provide information about the source of the PCI operation that MPC8245 is performing.

1.7.2 Memory Debug Address

When enabled, the debug address provides software disassemblers a simple way to reconstruct the 30-bit physical address for a memory bus transaction to SDRAM and ROM, Flash, or Port X. For SDRAM, these 16 debug address signals are sampled with the column address and chip-selects. For ROMs, Flash, and Port X devices, the debug address pins are sampled at the same time as the ROM address and can be used to recreate the 25-bit physical address with ROM address. Bus width of the interface limits the granularity of the reconstructed physical address (double words for 64-bit interfaces, words for 32-bit interfaces, and bytes for 8-bit interfaces).

1.7.3 Memory Interface Valid ($\overline{\text{MIV}}$)

The memory interface valid signal, $\overline{\text{MIV}}$, is asserted whenever SDRAM, Flash, or ROM addresses or data are present on the external memory bus. It is intended to help reduce the number of bus cycles that logic analyzers must store in memory during a debug trace.

1.7.4 Error Injection/Capture on Data Path

The MPC8245 provides hardware to exercise and debug the ECC and parity logic by allowing the user to inject multi-bit stuck-at faults onto the peripheral logic or memory data/parity buses and to capture the data/parity output on receipt of an ECC or parity error.

1.7.5 IEEE 1149.1 (JTAG)/Test Interface

The processor core provides IEEE 1149.1 functions for facilitating testing and software debugging. The IEEE 1149.1 test interface provides a means for boundary-scan testing the MPC8245 and the board to which it is attached.

1.8 Differences Between the MPC8245 and the MPC8240

The design philosophy of the MPC8245 is to maintain the MPC8240 base, but improve some features and add a few others for enhanced capability in the embedded market. The MPC8245 core is essentially the same as the MPC8240, but new features such as a DUART were added to the peripheral logic block. Differences are summarized in Table 1-3.

Table 1-3. Differences Between the MPC8245 and the MPC8240

Supported Feature	Additions to MPC8245
SDRAM	Supports register and inline buffer modes (flow-through no longer supported)
	Support for up to 2-Gbyte, 133 MHz SDRAM memory
	Supports up to 256-Mbit memory technology
ROM/Flash	Supports 272 Mbytes available ROM space (the added extended ROM mode supports 256 Mbytes of ROM or Port X)
	Supports a 16-bit width ROM data bus in addition to 8-, 32-, and 64-bit widths (MPC8240)
Port X	Supports a 16-bit ROM I/O port in addition to 8-, 32-, and 64-bit ports (MPC8240)
	Supports the $\overline{\text{DRDY}}$ signal and two additional chip selects (now four)
	Allows PCI writes to Port X
PCI Interface	PCI 2.2-compliant
	Adds a dual address cycle for 64-bit addressing
Address Translation Unit	Has two ATUs

Table 1-3. Differences Between the MPC8245 and the MPC8240 (continued)

Supported Feature	Additions to MPC8245
PIC	Adds a cascade function for the four PIC timers and counters
I^2C Controller	Accepts broadcast messages
Performance Monitor	Adds a system level performance monitor with interrupts and PCI arbitration monitor
Core and I/O Voltages	The electrical characteristics of the MPC8245 are different from those of the MPC8240. See the corresponding hardware specifications for each device.
DUART	Has dual 2-pin UARTs
	Configurable to single 4-pin UART mode
	Functionality selectable by reset configuration signal

Chapter 2
Signal Descriptions and Clocking

This chapter provides descriptions of the MPC8245 external signals. It describes each signal's behavior when the signal is asserted and negated when the signal is an input or an output.

NOTE

A bar over a signal name indicates that the signal is active low, such as $\overline{\text{AS}}$ (address strobe). Active-low signals are *asserted* (active) when they are low and *negated* when they are high. Signals that are not active low, such as nonmaskable interrupt (NMI), are *asserted* when they are high and *negated* when they are low.

Internal signals are depicted as lower case and in italics. For example, *sys_logic_clk* is an internal signal. These signals are referenced only as necessary for understanding the external functionality of the device.

This chapter discusses the following topics:

- The overview describes signals, contains a cross-reference of signals that serve multiple functions, and includes a listing of output signal states at reset.
- The signals sections describe each signal listed by functional block.
- The clock signals sections describe operations of the input and output clock signals on the MPC8245 and interactions between these signals.
- The reset configuration signals sections list signals and modes they define.

2.1 Signal Overview

MPC8245 signals are organized into the following groups:

- PCI interface signals
- Memory interface signals
- PIC control signals
- I^2C interface signals

- System control, power management, and debug signals
- Test/configuration signals
- Clock signals

Figure 2-1 illustrates the grouping of MPC8245 external signals. The *MPC8245 Integrated Processor Hardware Specifications* includes a pinout diagram and pin numbers as well as a listing of all the electrical and mechanical specifications.

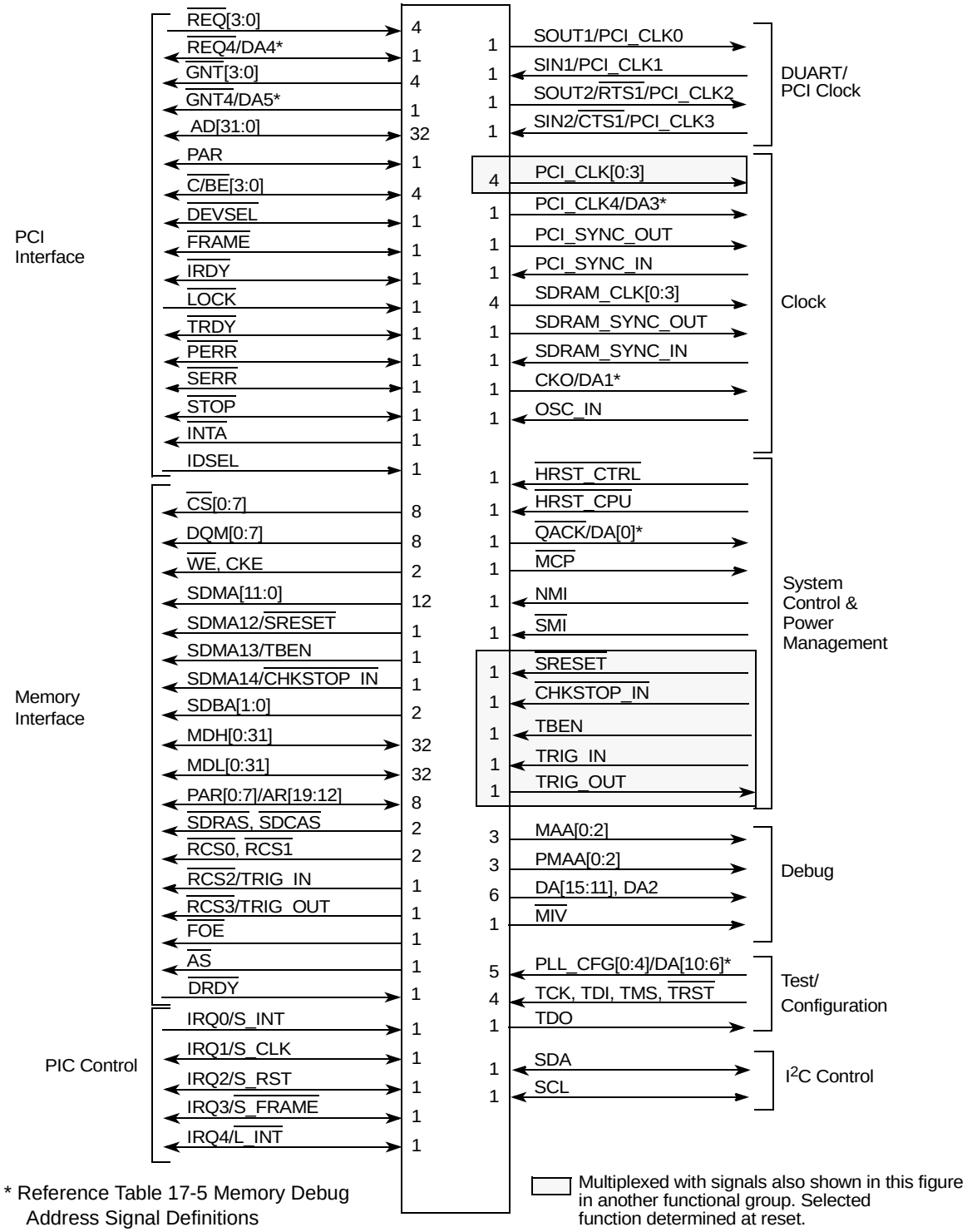


Figure 2-1. MPC8245 Signal Groups

2.1.1 Signal Cross Reference

The following sections provide a quick summary of signal functions. Table 2-1 provides the following information:

- an alphabetical cross-reference to the signals of the MPC8245
- signal names, interface, alternate functions, number of signals, and whether the signal is an input, output, or bidirectional
- direction of the multiplexed signal, which applies for the primary signal function listed in the first column of the table for that row (and does not apply for the state of the reset configuration signals)
- a pointer to the section in this chapter where the signal function is described

Table 2-1. MPC8245 Signal Cross Reference

Signal	Signal Name	Interface	Alternate Function(s)	Pins	I/O	Section #
AD[31:0]	Address/data	PCI	—	32	I/O	2.2.1.3
AR[19:12]	ROM address 19–12	Memory	PAR[0:7]	8	O	2.2.2.11
$\overline{\text{AS}}$ [1]	Address strobe	Memory	—	1	O	2.2.2.17
$\overline{\text{C/BE}}$[3:0]	Command/byte enable	PCI	—	4	I/O	2.2.1.5
$\overline{\text{CHKSTOP_IN}}$	Checkstop in	System control	SDMA14	1	I	2.2.6.6
CKE[1]	SDRAM clock enable	Memory	—	1	O	2.2.2.12
CKO	Debug clock	Clock	DA1	1	O	2.2.8.8
$\overline{\text{CS}}$[0:7]	SDRAM chip select	Memory	—	8	O	2.2.2.1
$\overline{\text{CTS1}}$	Clear to send UART1	DUART	SIN2/ PCI_CLK3	1	I	2.2.5.3
DA[15:11], DA2	Debug addr [15:11, 2]	Debug	—	6	O	2.2.6.10.3
DA[10:6]	Debug addr [10:6]	Debug	PLL_CFG[0:4]	5	O	2.2.6.10.3
DA5 DA4 DA3 DA1 DA0	Debug addr 5 Debug addr 4 Debug addr 3 Debug addr 1 Debug addr 0	Debug	GNT4 REQ4 PCI_CLK4 CKO QACK	5	O	2.2.6.10.3
$\overline{\text{DEVSEL}}$	Device select	PCI	—	1	I/O	2.2.1.6
DQM[0:7]	SDRAM data qualifier	Memory	—	8	O	2.2.2.2
$\overline{\text{DRDY}}$	ROM/Port X data ready	Memory	—	1	I	2.2.2.18
$\overline{\text{FOE}}$[1]	Flash output enable	Memory	—	1	O	2.2.2.16
$\overline{\text{FRAME}}$	Frame	PCI	—	1	I/O	2.2.1.7
$\overline{\text{GNT}}$[4:0] $\overline{\text{GNT4}}$/DA5[1]	PCI bus grant	PCI	$\overline{\text{GNT0}}$: PCI bus request $\overline{\text{GNT4}}$: DA5	5	O	2.2.1.2

Table 2-1. MPC8245 Signal Cross Reference (continued)

Signal	Signal Name	Interface	Alternate Function(s)	Pins	I/O	Section #
$\overline{\text{HRST_CPU}}$	Hard reset (processor)	System control	—	1	I	2.2.6.1.1
$\overline{\text{HRST_CTRL}}$	Hard reset (peripheral logic)	System control	—	1	I	2.2.6.1.2
IDSEL	ID select	PCI	—	1	I	2.2.1.15
$\overline{\text{INTA}}$	Interrupt request	PCI	—	1	O	2.2.1.14
$\overline{\text{IRDY}}$	Initiator ready	PCI	—	1	I/O	2.2.1.8
IRQ0	Interrupt 0	PIC control	S_INT	1	I	2.2.3.1
IRQ1	Interrupt 1	PIC control	S_CLK	1	I	2.2.3.1
IRQ2	Interrupt 2	PIC control	S_RST	1	I	2.2.3.1
IRQ3	Interrupt 3	PIC control	S_FRAME	1	I	2.2.3.1
IRQ4	Interrupt 4	PIC control	L_INT	1	I	2.2.3.1
$\overline{\text{L_INT}}$	Local interrupt	PIC control	IRQ4	1	O	2.2.3.3
$\overline{\text{LOCK}}$	Lock	PCI	—	1	I	2.2.1.9
MAA[0:2][1]	Memory addr attributes	Debug	—	3	O	2.2.6.10.1
$\overline{\text{MCP}}$[1]	Machine check	System control	—	1	O	2.2.6.3
MDH[0:31][1]	Data bus high	Memory	—	32	I/O	2.2.2.9
MDL[0:31] MDL0[1]	Data bus low	Memory	—	32	I/O	2.2.2.9
$\overline{\text{MIV}}$	Memory interface valid	Debug	—	1	O	2.2.6.10.4
NMI	Nonmaskable interrupt	System control	—	1	I	2.2.6.4
OSC_IN	System clock input	Clock	—	1	I	2.2.8.1
PAR	Parity	PCI	—	1	I/O	2.2.1.4
PAR[0:7]	Data parity 0–7	Memory	AR[19:12]	8	I/O	2.2.2.10
PCI_CLK0	PCI clock output 0	Clock	SOUT1	1	O	2.2.8.2
PCI_CLK1	PCI clock output 1	Clock	SIN1	1	O	2.2.8.2
PCI_CLK2	PCI clock output 2	Clock	SOUT2/$\overline{\text{RTS1}}$	1	O	2.2.8.2
PCI_CLK3	PCI clock output 3	Clock	SIN2/$\overline{\text{CTS1}}$	1	O	2.2.8.2
PCI_CLK4	PCI clock output 4	Clock	DA3	1	O	2.2.8.2
PCI_SYNC_OUT	PCI clock output	Clock	—	1	O	2.2.8.3
PCI_SYNC_IN	PCI clock input	Clock	—	1	I	2.2.8.4
$\overline{\text{PERR}}$	Parity error	PCI	—	1	I/O	2.2.1.11
PLL_CFG[0:4]	PLL configuration	Test/Configuration	DA[10:6]	5	I	2.2.7.1
PMAA[0:2][1]	PCI addr. attributes	Debug	—	3	O	2.2.6.10.2

Table 2-1. MPC8245 Signal Cross Reference (continued)

Signal	Signal Name	Interface	Alternate Function(s)	Pins	I/O	Section #
$\overline{\text{QACK}}$[1]	Quiesce acknowledge	Power management	DA0	1	O	2.2.6.8
$\overline{\text{RCS0}}$[1]	ROM/bank 0 select	Memory	—	1	O	2.2.2.15
$\overline{\text{RCS1}}$	ROM/bank 1 select	Memory	—	1	O	2.2.2.15
$\overline{\text{RCS2}}$	ROM/bank 2 select	Memory	TRIG_IN	1	O	2.2.2.15
$\overline{\text{RCS3}}$	ROM/bank 3 select	Memory	TRIG_OUT	1	O	2.2.2.15
$\overline{\text{REQ}}$[4:0] $\overline{\text{REQ4}}$/DA4	PCI bus request	PCI	$\overline{\text{REQ0}}$: PCI bus grant $\overline{\text{REQ4}}$: DA4	5	I I/O	2.2.1.1
$\overline{\text{RTS1}}$	Request to send UART1	DUART	SOUT2/ PCI_CLK2	1	O	2.2.5.4
S_CLK	Serial interrupt clock	PIC control	IRQ1	1	O	2.2.3.2.2
SCL	Serial clock	I^2C control	—	1	I/O	2.2.4.2
SDA	Serial data	I^2C control	—	1	I/O	2.2.4.1
SDBA0	SDRAM bank select 0	Memory	See Table 6-2	1	O	2.2.2.8
SDBA1	SDRAM bank select 1	Memory		1	O	2.2.2.8
$\overline{\text{SDCAS}}$	SDRAM column access strobe	Memory	—	1	O	2.2.2.14
SDMA[1:0][1]	SDRAM address 1–0	Memory	See Table 6-2	2	O	2.2.2.4
SDMA[11:2]	SDRAM address 11–2	Memory		10	O	2.2.2.4
SDMA12	SDRAM address 12	Memory		1	O	2.2.2.5
SDMA13	SDRAM address 13	Memory		1	O	2.2.2.6
SDMA14	SDRAM address 14	Memory			O	2.2.2.7
SDRAM_CLK[0:3]	SDRAM clock outputs	Clock	—	4	O	2.2.8.5
SDRAM_SYNC_OUT	SDRAM clock output	Clock	—	1	O	2.2.8.6
SDRAM_SYNC_IN	SDRAM feedback clock	Clock	—	1	I	2.2.8.7
$\overline{\text{SDRAS}}$	SDRAM row address strobe	Memory	—	1	O	2.2.2.13
$\overline{\text{SERR}}$	System error	PCI	—	1	I/O	2.2.1.12
$\overline{\text{S_FRAME}}$	Serial interrupt frame	PIC control	IRQ3	1	O	2.2.3.2.4
SIN1	Serial data in UART1	DUART	PCI_CLK1	1	I	2.2.5.1
SIN2	Serial data in UART2	DUART	$\overline{\text{CTS1}}$/PCI_CLK3	1	I	2.2.5.1
S_INT	Serial interrupt stream	PIC Control	IRQ0	1	I	2.2.3.2.1
$\overline{\text{SMI}}$	System management interrupt	System control	—	1	I	2.2.6.5
SOUT1	Serial data out UART1	DUART	PCI_CLK0	1	O	2.2.5.2

Table 2-1. MPC8245 Signal Cross Reference (continued)

Signal	Signal Name	Interface	Alternate Function(s)	Pins	I/O	Section #
SOUT2	Serial data out UART2	DUART	$\overline{\text{RTS1}}$/PCI_CLK2	1	O	2.2.5.2
S_RST	Serial interrupt reset	PIC control	IRQ2	1	O	2.2.3.2.3
$\overline{\text{SRESET}}$	Soft reset	System control	SDMA12	1	I	2.2.6.2
$\overline{\text{STOP}}$	Stop	PCI	—	1	I/O	2.2.1.13
TBEN	Time base enable	System control	SDMA13	1	I	2.2.6.7
TCK	JTAG test clock	Test	—	1	I	2.2.7.2
TDO	JTAG test data output	Test	—	1	O	2.2.7.4
TDI	JTAG test data Input	Test	—	1	I	2.2.7.3
TMS	JTAG test mode select	Test	—	1	I	2.2.7.5
$\overline{\text{TRDY}}$	Target ready	PCI	—	1	I/O	2.2.1.10
TRIG_IN	Watchpoint trigger in	System control	RCS2	1	I	2.2.6.9.1
TRIG_OUT	Watchpoint trigger out	System control	RCS3	1	O	2.2.6.9.2
$\overline{\text{TRST}}$	JTAG test reset	Test	—	1	I	2.2.7.6
$\overline{\text{WE}}$	Write enable	Memory	—	1	O	2.2.2.3

[1] The MPC8245 samples these signals at the negation of reset to determine the reset configuration. After sampling, they assume normal functions. See Section 2.4, “Configuration Signals Sampled at Reset,” for more information about their function during reset.

2.1.2 Output Signal States During Reset

When a system reset is recognized (assertion of $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$), the MPC8245 ends all current internal and external transactions and releases all bidirectional I/O signals to a high-impedance state. See Section 14.2.1, “System Reset,” for a complete description of the reset functionality.

A number of signals serve alternate functions as configuration input signals during system reset. Section 2.4, “Configuration Signals Sampled at Reset” describes their default values and interpretation of their voltage levels during reset.

During reset, the MPC8245 ignores most input signals (except for PCI_SYNC_IN and the reset configuration signals) and drives most of the output signals to an inactive state.

Table 2-2 shows the states of the output-only signals that are not used as reset configuration signals during system reset.

Table 2-2. Output Signal States During System Reset

Interface	Signal	State During System Reset
PCI	$\overline{\text{GNT}}$[3:0] INTA	High impedance
Memory	DQM[0:7]	Driven high
	$\overline{\text{CS}}$[0:7] RCS1 SDRAS SDCAS WE	Negated
	SDMA[11:2], SDBA0, SDBA1	Driven
	SDMA12/$\overline{\text{SRESET}}$ SDMA13/TBEN SDMA14/$\overline{\text{CHKSTOP_IN}}$	Driven if extended addressing enabled; otherwise, high impedance
	PAR[0:7]/AR[19:12]	High impedance
Clock	SOUT1/PCI_CLK0 SOUT2/PCI_CLK2 PCI_SYNC_OUT SDRAM_CLK[0:3] SDRAM_SYNC_OUT CKO	Driven
System control	TRIG_OUT/$\overline{\text{RCS3}}$	High impedance
Debug	DA[11:15], DA2	Driven
Test/Configuration	TDO	Negated

2.2 Detailed Signal Descriptions

The following subsections describe MPC8245 input and output signals, meanings of their different states, and relative timing information for assertion and negation. In cases where signals serve multiple functions (and have multiple names), they are described individually for each function.

2.2.1 PCI Interface Signals

This section provides descriptions of the PCI interface signals on the MPC8245. Note that throughout this manual, signals and bits of the PCI interface are referenced in little-endian format. For more information about the operation of the MPC8245 PCI interface, see Chapter 7, “PCI Bus Interface.” Refer to the *PCI Local Bus Specification*, Revision 2.1 for a thorough description of the PCI local bus and specific signal-to-signal timing relationships for the PCI bus.

2.2.1.1 PCI Bus Request ($\overline{\text{REQ}}$[4:0])—Input

The PCI bus request signals ($\overline{\text{REQ}}$[4:0]) are inputs on the MPC8245, and have a different meaning depending on whether the MPC8245 PCI arbiter is enabled or disabled. The PCI $\overline{\text{REQ}}$*n* signals are point-to-point, and every master has its own $\overline{\text{REQ}}$*n* signal.

2.2.1.1.1 PCI Bus Request ($\overline{\text{REQ}}$[4:0])—Internal Arbiter Enabled

The MPC8245 PCI arbiter is enabled by a low value on the reset configuration pin MAA2 or by the setting of bit 15 of the PCI arbitration control register. In this case, the $\overline{\text{REQ}}$[4:0] signals are used with the $\overline{\text{GNT}}$[4:0] signals as the arbiter for up to five PCI masters. The state meaning for the $\overline{\text{REQ}}$[4:0] input signals in this case is the following:

State Meaning Asserted: External devices are requesting control of the PCI bus. The MPC8245 acts on the requests as described in Section 7.2, “PCI Bus Arbitration.”

Negated: Indicates that no external devices want to use the PCI bus.

2.2.1.1.2 PCI Bus Request ($\overline{\text{REQ}}$[4:0])—Internal Arbiter Disabled

The MPC8245 PCI arbiter is disabled by a high value on the reset configuration pin MAA2 or by the clearing of bit 15 of the PCI arbitration control register. In this case, the $\overline{\text{REQ0}}$ becomes the PCI bus grant input for the MPC8245, and is asserted when the external arbiter is granting the use of the PCI bus to the MPC8245. Note that if the $\overline{\text{REQ0}}$ input signal is asserted before running a PCI transaction is necessary, the MPC8245 $\overline{\text{GNT0}}$ signal does not assert (that is, the bus is parked) when a PCI transaction is to be run.

The $\overline{\text{REQ}}$[4:1] input signals are ignored when the internal arbiter is disabled. The state meaning of the $\overline{\text{REQ0}}$ signal when the internal arbiter is disabled is the following:

State Meaning Asserted: The $\overline{\text{REQ0}}$ signal indicates that the MPC8245 is granted control of the PCI bus. If $\overline{\text{REQ0}}$ is asserted before the MPC8245 has a transaction to perform (that is, the MPC8245 is parked), the MPC8245 drives AD[31:0], $\overline{\text{C/BE}}$[3:0], and PAR to stable (but meaningless) states until they are needed for a legitimate transaction.

Negated: $\overline{\text{REQ0}}$ is negated when the MPC8245 is not granted control of the PCI bus.

2.2.1.2 PCI Bus Grant ($\overline{\text{GNT}}$[4:0])—Output

The PCI bus grant ($\overline{\text{GNT}}$[4:0]) signals are outputs on the MPC8245 and have different meanings that depend on whether the MPC8245 PCI arbiter is enabled or disabled. The PCI $\overline{\text{GNT}}$*n* signals are point-to-point; every master has its own $\overline{\text{GNT}}$*n* signal.

2.2.1.2.1 PCI Bus Grant ($\overline{\text{GNT}}$[4:0])—Internal Arbiter Enabled

The MPC8245 PCI arbiter is enabled by a low value on the reset configuration pin MAA2 or by the setting of bit 15 of the PCI arbitration control register. In this case, the $\overline{\text{GNT}}$[4:0] signals are used with the $\overline{\text{REQ}}$[4:0] signals as the arbiter for up to five PCI masters. The state meaning for the $\overline{\text{GNT}}$[4:0] input signals in this case is the following:

State Meaning Asserted: The MPC8245 has granted control of the PCI bus to a requesting master, using the priority scheme described in Section 7.2, "PCI Bus Arbitration." The MPC8245 asserts only one $\overline{\text{GNT}}$*n* signal during any clock cycle.

Negated: Indicates that the MPC8245 has not granted control of the PCI bus and that external devices may not initiate a PCI transaction.

2.2.1.2.2 PCI Bus Grant ($\overline{\text{GNT}}$[4:0])—Internal Arbiter Disabled

The MPC8245 PCI arbiter is disabled by a high value on the reset configuration pin MAA2 or by the clearing of bit 15 of the PCI arbitration control register. In this case, the $\overline{\text{GNT0}}$ becomes the PCI bus request output for the MPC8245 and is asserted when the MPC8245 must run a PCI transaction. If the $\overline{\text{REQ0}}$ input signal is asserted before the need to run a PCI transaction, the $\overline{\text{GNT0}}$ signal does not assert (the bus is parked) when a PCI transaction is to be run. The state meaning for the $\overline{\text{GNT}}$[4:0] input signals when the internal arbiter is disabled is the following:

State Meaning Asserted: The MPC8245 asserts the $\overline{\text{GNT0}}$ signal as the PCI bus request output signal. $\overline{\text{GNT}}$[4:1] signals do not assert in this case.

Negated: The $\overline{\text{GNT}}$[4:1] signals are driven high (negated) in this mode. $\overline{\text{GNT0}}$ is negated when the MPC8245 is not requesting control of the PCI bus or the bus is parked on the MPC8245.

2.2.1.3 PCI Address/Data Bus (AD[31:0])

The PCI address/data bus (AD[31:0]) consists of 32 signals that are both input and output signals on the MPC8245.

2.2.1.3.1 Address/Data (AD[31:0])—Output

The state meaning for AD[31:0] as outputs is the following:

State Meaning Asserted/Negated: Represents the physical address during the address phase of a PCI transaction initiated by the MPC8245. During a data phase of a PCI transaction, AD[31:0] contain data being driven.

The AD[7:0] signals define the least-significant byte and AD[31:24] the most-significant byte.

2.2.1.3.2 Address/Data (AD[31:0])—Input

The state meaning for AD[31:0] as inputs is the following:

State Meaning Asserted/Negated: Represents the address to be decoded as a check for device select during an address phase of a PCI transaction or data being received during a data phase of a PCI transaction.

2.2.1.4 Parity (PAR)

The PCI parity (PAR) signal is both an input and output signal on the MPC8245. See Section 7.6.1, “PCI Parity,” for more information about PCI parity.

2.2.1.4.1 Parity (PAR)—Output

The state meaning for PAR as an output signal is the following:

State Meaning Asserted: This signal is driven by the MPC8245 to indicate odd parity across the AD[31:0] and $\overline{\text{C/BE}}$[3:0] signals (driven by the MPC8245) during the address and data phases of a transaction.

Negated: Indicates even parity across the AD[31:0] and $\overline{\text{C/BE}}$[3:0] signals driven by the MPC8245 during address and data phases.

2.2.1.4.2 Parity (PAR)—Input

The state meaning for PAR as an input signal is the following:

State Meaning Asserted: Indicates odd parity that another PCI master or the PCI target drives during read data phases.

Negated: Indicates even parity that another PCI master or the PCI target drives during read data phases.

2.2.1.5 Command/Byte Enable ($\overline{\text{C/BE}}$[3:0])

The four command/byte enable ($\overline{\text{C/BE}}$[3:0]) signals are both input and output signals on the MPC8245.

2.2.1.5.1 Command/Byte Enable ($\overline{\text{C/BE}}$[3:0])—Output

The state meaning for $\overline{\text{C/BE}}$[3:0] as output signals is the following:

State Meaning Asserted/Negated: During the address phase, $\overline{\text{C/BE}}$[3:0] define the bus command of the transaction initiated by the MPC8245 as a PCI master. Table 2-3 summarizes the PCI bus command encodings. See Section 7.3.2, “PCI Bus Commands,” for more detailed information about the bus commands.

During the data phase, $\overline{\text{C/BE}}$[3:0] are used as *byte enables*, which determine the byte lanes that carry meaningful data. The $\overline{\text{C/BE0}}$ signal applies to the least-significant byte.

Table 2-3. PCI Command Encodings

$\overline{\text{C/BE}}$[3:0]	PCI Command
0000	Interrupt acknowledge
0001	Special cycle
0010	I/O read
0011	I/O write
0100	Reserved
0101	Reserved
0110	Memory read
0111	Memory write
1000	Reserved
1001	Reserved
1010	Configuration read
1011	Configuration write
1100	Memory read multiple
1101	Dual address cycle [1]
1110	Memory read line
1111	Memory write and invalidate

[1] The MPC8245 does not generate this command or the reserved commands.

2.2.1.5.2 Command/Byte Enable ($\overline{\text{C/BE}}$[3:0])—Input

The state meaning for $\overline{\text{C/BE}}$[3:0] as input signals is the following:

State Meaning Asserted/Negated: During the address phase, $\overline{\text{C/BE}}$[3:0] indicate the command that another master is sending. The MPC8245 uses the value on these signals (in addition to the address) to determine whether it is a target for a transaction. Table 2-3 summarizes the PCI bus command encodings. See Section 7.3.3, “Addressing,” for more information.

During the data phase, $\overline{\text{C/BE}}$[3:0] indicate which byte lanes are valid.

2.2.1.6 Device Select ($\overline{\text{DEVSEL}}$)

The device select ($\overline{\text{DEVSEL}}$) signal is both an input and output on the MPC8245.

2.2.1.6.1 Device Select ($\overline{\text{DEVSEL}}$)—Output

The state meaning for $\overline{\text{DEVSEL}}$ as an output is the following:

State Meaning Asserted: Indicates that the MPC8245 has decoded the address of a PCI transaction and that it is the target of the current access.

Negated: Indicates that the MPC8245 has decoded the address and is not the target of the current access.

2.2.1.6.2 Device Select ($\overline{\text{DEVSEL}}$)—Input

The state meaning for $\overline{\text{DEVSEL}}$ as an input signal is the following:

State Meaning Asserted: Indicates that some PCI target (other than the MPC8245) has decoded its address as the target of the current access. This operation is useful to the MPC8245 when it is the initiator of a PCI transaction.

Negated: Indicates that no PCI target was selected.

2.2.1.7 Frame ($\overline{\text{FRAME}}$)

The frame ($\overline{\text{FRAME}}$) signal is both an input and output on the MPC8245.

2.2.1.7.1 Frame ($\overline{\text{FRAME}}$)—Output

The state meaning for $\overline{\text{FRAME}}$ as an output is the following:

State Meaning Asserted: Indicates that the MPC8245, acting as a PCI master, is initiating a bus transaction. While $\overline{\text{FRAME}}$ is asserted, data transfers may continue.

Negated: If $\overline{\text{IRDY}}$ is asserted, indicates that the PCI transaction is in the final data phase. If $\overline{\text{IRDY}}$ is negated, it indicates that the PCI bus is idle.

2.2.1.7.2 Frame ($\overline{\text{FRAME}}$)—Input

The state meaning for $\overline{\text{FRAME}}$ as an input signal is the following:

State Meaning Asserted: Indicates that another PCI master is initiating a bus transaction and causes the MPC8245 to decode the address and the command signals to see if it is the target of the transaction.

Negated: Indicates that the transaction is in the final data phase or that the bus is idle.

2.2.1.8 Initiator Ready ($\overline{\text{IRDY}}$)

The initiator ready ($\overline{\text{IRDY}}$) signal is both an input and output on the MPC8245.

2.2.1.8.1 Initiator Ready ($\overline{\text{IRDY}}$)—Output

The state meaning for $\overline{\text{IRDY}}$ as an output is the following:

State Meaning Asserted: Indicates that the MPC8245, acting as a PCI master, can complete the current data phase of a PCI transaction. During a write, the MPC8245 asserts $\overline{\text{IRDY}}$ to indicate that valid data is present on AD[31:0]. During a read, the MPC8245 asserts $\overline{\text{IRDY}}$ to indicate that it is prepared to accept data.

Negated: Indicates that the PCI target must wait before the MPC8245, acting as a PCI master, can complete the current data phase. During a write, the MPC8245 negates $\overline{\text{IRDY}}$ to insert a wait cycle when it cannot provide valid data to the target. During a read, the MPC8245 negates $\overline{\text{IRDY}}$ to insert a wait cycle when it cannot accept data from the target.

2.2.1.8.2 Initiator Ready ($\overline{\text{IRDY}}$)—Input

The state meaning for $\overline{\text{IRDY}}$ as an input signal is the following:

State Meaning Asserted: Indicates another PCI master is able to complete the current data phase of a transaction.

Negated: If $\overline{\text{FRAME}}$ is asserted, it indicates a wait cycle from another master. The MPC8245 uses this indication to insert wait cycles when it is a target of a PCI transaction. If $\overline{\text{FRAME}}$ is negated, it indicates the PCI bus is idle.

2.2.1.9 Lock ($\overline{\text{LOCK}}$)—Input

The lock ($\overline{\text{LOCK}}$) signal is an input on the MPC8245. See Section 7.5, “Exclusive Access,” for more information. The state meaning for the $\overline{\text{LOCK}}$ input signal is the following:

State Meaning Asserted: Indicates that a master is requesting exclusive access to memory, which may require multiple transactions to complete.

Negated: Indicates that a normal operation is occurring on the bus, or an access to a locked target is occurring.

2.2.1.10 Target Ready ($\overline{\text{TRDY}}$)

The target ready ($\overline{\text{TRDY}}$) signal is both an input and output signal on the MPC8245.

2.2.1.10.1 Target Ready ($\overline{\text{TRDY}}$)—Output

The state meaning for $\overline{\text{TRDY}}$ as an output signal.

State Meaning Asserted: Indicates that the MPC8245, acting as a PCI target, can complete the current data phase of a PCI transaction. During a read, the MPC8245 asserts $\overline{\text{TRDY}}$ to indicate that valid data is present on AD[31:0]. During a write, the MPC8245 asserts $\overline{\text{TRDY}}$ to indicate that it is prepared to accept data.

Negated: Indicates that the PCI initiator must wait before the MPC8245, acting as a PCI target, can complete the current data phase. During a read, the MPC8245 negates $\overline{\text{TRDY}}$ to insert a wait cycle when it cannot provide valid data to the initiator. During a write, the MPC8245 negates $\overline{\text{TRDY}}$ to insert a wait cycle when it cannot accept data from the initiator.

2.2.1.10.2 Target Ready ($\overline{\text{TRDY}}$)—Input

The state meaning for $\overline{\text{TRDY}}$ as an input signal is the following:

State Meaning Asserted: Indicates that another PCI target is able to complete the current data phase of a transaction. If the MPC8245 is the initiator of the transaction, it latches the data (on a read) or cycles the data on a write.

Negated: Indicates a wait cycle that a target needs. If the MPC8245 is the initiator of the transaction, it waits to latch the data (on a read) or continues to drive the data (on a write).

2.2.1.11 Parity Error ($\overline{\text{PERR}}$)

The PCI parity error ($\overline{\text{PERR}}$) signal is both an input and output signal on the MPC8245. See Section 14.2.3.2, “Parity Error (PERR),” and Section 4.8.2, “Error Enabling and Detection Registers,” for more information about setting up the MPC8245 to report parity errors. The PCI initiator drives $\overline{\text{PERR}}$ on read operations; the PCI target drives $\overline{\text{PERR}}$ on write operations.

2.2.1.11.1 Parity Error ($\overline{\text{PERR}}$)—Output

The state meaning for $\overline{\text{PERR}}$ as an output signal is the following:

State Meaning Asserted: Indicates that the MPC8245, acting as a PCI agent, detected a data parity error.

Negated: Indicates no error.

2.2.1.11.2 Parity Error ($\overline{\text{PERR}}$)—Input

The state meaning for $\overline{\text{PERR}}$ as an input signal is the following:

State Meaning Asserted: Indicates that another PCI agent detected a data parity error while the MPC8245 was sourcing data, The MPC8245 was acting as the PCI initiator during a write or was acting as the PCI target during a read.

Negated: Indicates no error.

2.2.1.12 System Error ($\overline{\text{SERR}}$)

The PCI system error ($\overline{\text{SERR}}$) signal is both an input and output signal on the MPC8245. It is an open-drain signal, and multiple devices on the PCI bus can drive it. Refer to Section 14.2.3.1, “System Error (SERR),” and Section 4.8.2, “Error Enabling and Detection Registers,” for more information about system errors that the MPC8245 drives and reports.

2.2.1.12.1 System Error ($\overline{\text{SERR}}$)—Output

The state meaning for $\overline{\text{SERR}}$ as an output signal is the following:

State Meaning Asserted: Indicates that an address parity error, a target-abort (when the MPC8245 is acting as the target), or some other system error (where the result is a catastrophic error) is detected.

Negated: Indicates no error.

2.2.1.12.2 System Error ($\overline{\text{SERR}}$)—Input

The state meaning for $\overline{\text{SERR}}$ as an input signal is the following:

State Meaning Asserted: Indicates that a PCI agent (other than the MPC8245) has detected a catastrophic error.

Negated: Indicates no error.

2.2.1.13 Stop ($\overline{\text{STOP}}$)

The stop ($\overline{\text{STOP}}$) signal is both an input and output signal on the MPC8245. Refer to Section 7.4.3.2, “Target-Initiated Termination,” for more information about using the $\overline{\text{STOP}}$ signal.

2.2.1.13.1 Stop ($\overline{\text{STOP}}$)—Output

The state meaning for $\overline{\text{STOP}}$ as an output signal is the following:

State Meaning Asserted: Indicates that the MPC8245, acting as a PCI target, is requesting that the initiator stop the current transaction.

Negated: Indicates that the current transaction can continue.

2.2.1.13.2 Stop ($\overline{\text{STOP}}$)—Input

The state meaning for $\overline{\text{STOP}}$ as an input signal is the following:

State Meaning Asserted: Indicates that when the MPC8245 acts as a PCI initiator, it receives a request from the target to stop the current transaction.

Negated: Indicates that the current transaction can continue.

2.2.1.14 Interrupt Request ($\overline{\text{INTA}}$)—Output

The state meaning for $\overline{\text{INTA}}$, which is primarily used when the MPC8245 is programmed in agent mode, is the following:

State Meaning Asserted: Indicates that the MPC8245 is requesting an interrupt on the PCI bus. The on-chip DMA controller, DUART, I^2C controller, watchpoint facility, and message unit can cause these interrupts.

Negated: Indicates that the MPC8245 is not requesting an interrupt on the PCI bus.

2.2.1.15 ID Select (IDSEL)—Input

The state meaning for IDSEL is the following. See Section 7.3.3.3, “Configuration Space Addressing,” for more information about the role of the IDSEL signal in PCI configuration transactions.

State Meaning Asserted: When the $\overline{\text{C/BE}}$[3:0] encoding is set to configuration read/write, IDSEL indicates that the PCI configuration registers on the MPC8245 are being accessed.

Negated: Indicates that this device in progress has no configuration access.

Note that if the MPC8245 issues a PCI configuration transactions to itself (that is, a PCI configuration transactions is initiated by the MPC8245 and IDSEL is asserted), the MPC8245 performs a master-abort. The MPC8245 should use the method described in Section 4.1, “Configuration Register Access,” to access its own configuration registers. If the MPC8245 is in host mode and other PCI agents do not need to access the MPC8245 configuration space, Motorola recommends pulling down that signal.

2.2.2 Memory Interface Signals

The memory interface supports synchronous DRAMs (SDRAMs) and either standard ROM or Flash devices. Some of the memory interface signals perform different functions (and an alternate name describes them) depending on the RAM and ROM configurations. This section provides a brief description of the memory interface signals on the MPC8245, listed individually by both their primary and alternate names, describing the relevant function in each section. For more information about the operation of the memory interface, see Chapter 6, “Memory Interface.”

2.2.2.1 SDRAM Command Select ($\overline{\text{CS}}$[0:7])—Output

The eight SDRAM command select ($\overline{\text{CS}}$[0:7]) signals are output on the MPC8245. The state meaning and timing comments for the $\overline{\text{CS}}n$ output signals are the following:

State Meaning Asserted: Selects an SDRAM bank to perform a memory operation.

Negated: Indicates no SDRAM action during the current cycle.

Timing Comments Assertion: The MPC8245 asserts the $\overline{\text{CS}}n$ signal to begin a memory cycle. See the *MPC8245 Integrated Processor Hardware Specifications* for more timing information.

2.2.2.2 SDRAM Data Input/Output Mask (DQM[0:7])—Output

The eight SDRAM data input/output mask (DQM[0:7]) signals are outputs on the MPC8245. The state meaning and timing comments for the DQM*n* output signals are explained in this section. DQM0 connects to the most significant byte select, and DQM7 connects to the least significant byte select.

State Meaning Asserted: Prevents writing to SDRAM. Note that the DQM*n* signals are active-high for SDRAM. DQM*n* is part of the SDRAM command encoding. See Section 6.2, “SDRAM Interface Operation,” for more information.

Negated: Allows a read or write operation to SDRAM.

Timing Comments Assertion: See the *MPC8245 Integrated Processor Hardware Specifications* for more timing information.

2.2.2.3 Write Enable ($\overline{WE}$)—Output

The write enable ($\overline{WE}$) signal is an output on the MPC8245. For SDRAM, $\overline{WE}$ is part of the SDRAM command encoding. See Section 6.2, "SDRAM Interface Operation," for more information. The state meaning and timing comments for the $\overline{WE}$ output signal for Flash writes are the following:

State Meaning Asserted: Enables writing to Flash.

Negated: No Flash write operation is pending.

Timing Comments Assertion: For SDRAM, the MPC8245 asserts $\overline{WE}$ concurrent with $\overline{SDCAS}$ for write operations. For writes to base or extended ROM space, the MPC8245 asserts $\overline{WE}$ one clock cycle after $\overline{RCS}n$ is asserted.

Negation: For writes to base or extended ROM space, the MPC8245 negates $\overline{WE}$ one clock after $\overline{RCS}n$ is negated.

For Flash, the MPC8245 asserts $\overline{WE}$ one clock cycle after $\overline{RCSn}$ is asserted and negates $\overline{WE}$ one clock cycle after $\overline{RCSn}$ is negated.

2.2.2.4 SDRAM Address (SDMA[11:0])—Output

The SDMA[11:0] signals carry 12 of the address bits for the memory interface. For SDRAMs, they correspond to the row and column address bits.

State Meaning Asserted/Negated: Contain different portions of the address depending on the size of memory in use, the type of memory in use (SDRAM, ROM or Flash) and the phase of the transaction. See Section 6.2.2, "SDRAM Address Multiplexing," Section 6.3.1.1, "Base ROM Address Multiplexing," and Section 6.3.2.1, "Extended ROM Address Multiplexing," for a complete description of the mapping of these signals in all cases.

Timing Comments Assertion: See the *MPC8245 Integrated Processor Hardware Specifications* for more timing information. For ROM and Flash, the address is valid with the assertion of $\overline{RCS0}$.

2.2.2.5 SDRAM Address 12 (SDMA12)—Output

The SDMA12 signal is similar to SDMA[11:0] in that it corresponds to different row or column address bits, depending on the memory in use. SDMA12 is used in extended address mode. See Section 6.2.2, "SDRAM Address Multiplexing" and Section 2.4, "Configuration Signals Sampled at Reset," for more information.

State Meaning Asserted/Negated: See Section 6.2.2, "SDRAM Address Multiplexing, Section 6.3.1.1, "Base ROM Address Multiplexing,"

and Section 6.3.2.1, “Extended ROM Address Multiplexing,” for a complete description of the mapping of this signal in all cases.

Timing Comments Assertion/Negation: The same as SDMA[11:0]

2.2.2.6 SDRAM Address 13 (SDMA13)—Output

The SDMA13 signal is similar to SDMA[11:0] in that it corresponds to different row or column address bits, depending on the memory in use. SDMA13 is multiplexed with TBEN and is used in extended addressing mode. See 6.3.2, “Extended ROM Interface,” for more information.

State Meaning Asserted/Negated: See Section 6.3.2.1, “Extended ROM Address Multiplexing,” for a complete description of the mapping of this signal in all cases.

Timing Comments Assertion/Negation: The same as SDMA[11:0]

2.2.2.7 SDRAM Address 14 (SDMA14)—Output

The SDMA14 signal is similar to SDMA[11:0] in that it corresponds to different row or column address bits, depending on the memory in use. SDMA14 is multiplexed with $\overline{\text{CHKSTOP_IN}}$ and is used in extended addressing mode. See 6.3.2, “Extended ROM Interface,” for more information.

State Meaning Asserted/Negated: See Section 6.3.2.1, “Extended ROM Address Multiplexing,” for a complete description of the mapping of this signal in all cases.

Timing Comments Assertion/Negation: The same as SDMA[11:0]

2.2.2.8 SDRAM Internal Bank Select 0–1 (SDBA0, SDBA1)—Output

The SDBA[1:0] signals are similar to SDMA[11:0] in that they correspond to different row or column address bits, depending on the memory in use. They are used only for the SDRAM interface.

State Meaning Asserted/Negated: Selects the SDRAM internal bank to be activated during the row address phase and selects the SDRAM internal bank for the read or write operation during the column address phase of the memory access. See Section 6.2.2, “SDRAM Address Multiplexing,” for a complete description of the mapping of these signals in all cases.

Timing Comments Assertion/Negation: See the *MPC8245 Integrated Processor Hardware Specifications* for more timing information.

2.2.2.9 Memory Data Bus (MDH[0:31], MDL[0:31])

The memory data bus (MDH[0:31], MDL[0:31]) consists of 64 signals that are both input and output signals on the MPC8245. The data bus is comprised of two halves: *memory data bus high* (MDH[0:31]) and *memory data bus low* (MDL[0:31]).

The MPC8245 can also be configured to operate with a 32-bit data bus on the memory interface by driving the reset configuration signal MDL0 low during reset. When the MPC8245 is configured with a 32-bit data bus, the bus operates in the same way as when configured with a 64-bit data bus, except that only MDH[0:31] is used and MDL[0:31] can be left floating (except that it is driven by the MPC8245). For more information about other data bus sizes available for the ROM/Flash/Port X interfaces, see Chapter 6, "Memory Interface."

Table 2-4 specifies the byte lane assignments (and data parity signal correspondence) for the transfer of an aligned double-word in both 64- and 32-bit modes.

Table 2-4. Memory Data Bus Byte Lane Assignments

Data Bus Signals	Byte Lane	
	64-Bit Mode	32-Bit Mode
MDH[0:7]	0 (MSB)	0 (MSB), 4
MDH[8:15]	1	1, 5
MDH[16:23]	2	2, 6
MDH[24:31]	3	3, 7 (LSB)
MDL[0:7]	4	x
MDL[8:15]	5	x
MDL[16:23]	6	x
MDL[24:31]	7 (LSB)	x

2.2.2.9.1 Memory Data Bus (MDH[0:31], MDL[0:31])—Output

The state meaning and timing comments for the memory data bus as output signals are the following:

State Meaning Asserted/Negated: Represents the value of data that the MPC8245 is driving.

Timing Comments Assertion/Negation: For SDRAM, the data bus signals are valid on the next rising edge of *sys-logic-clk* after DQM[0:7] is asserted for a write command. For ROM/Flash memory and Port X, the data bus signals are valid on two cycles after the assertion of $\overline{\text{RCS0}}$.

2.2.2.9.2 Memory Data Bus (MDH[0:31], MDL[0:31])—Input

The state meaning and timing comments for the data bus as input signals are the following. Note that MDL0 is a reset configuration input signal.

State Meaning Asserted/Negated: Represents the value of data that the memory subsystem is driving on a read.

Timing Comments Assertion/Negation: For a memory read transaction, the data bus signals are valid at a time, depending on the memory interface configuration parameters. Refer to Chapter 4, “Configuration Registers,” and Chapter 6, “Memory Interface,” for more information.

2.2.2.10 Data Parity/ECC (PAR[0:7])

The eight data parity/ECC (PAR[0:7]) signals are both input and output signals on the MPC8245.

2.2.2.10.1 Data Parity (PAR[0:7])—Output

The state meaning and timing comments for PAR[0:7] as output signals are the following:

State Meaning Asserted/Negated: Represents the byte parity or ECC bits that are being written to memory (PAR0 is the most-significant parity bit and corresponds to byte lane 0, which is selected by DQM0). The data parity signals are asserted or negated appropriately to provide odd parity (including the parity bit) or ECC. Note that in 32-bit mode, PAR[4:7] are driven low.

Timing Comments Assertion/Negation: PAR[0:7] are valid concurrent with MDH[0:31] and MDL[0:31].

2.2.2.10.2 Data Parity (PAR[0:7])—Input

The state meaning and timing comments for PAR[0:7] as input signals are the following:

State Meaning Asserted/Negated: Represents the byte parity or ECC bits being read from memory (PAR0 is the most-significant parity bit and corresponds to byte lane 0, which is selected by DQM0).

Timing Comments Assertion/Negation: PAR[0:7] are valid concurrent with MDH[0:31] and MDL[0:31].

2.2.2.11 ROM Address 19:12 (AR[19:12])—Output

The ROM address 19–12 (AR[19:12]) signals are output signals only for the ROM address function. Note that these signals are both input and output signals for the memory parity

function (PAR[0:7]). The state meaning and timing comments for AR[19:12] as output signals are the following:

State Meaning Asserted/Negated: Represents bits 19–12 of the ROM/Flash address. The other ROM address bits are provided by AR[10:0], as shown in Section 6.3.1, “Base ROM Interface Operation.”

Timing Comments Assertion/Negation: The ROM address is valid on assertion of $\overline{\text{RCS}}$[0:3].

2.2.2.12 SDRAM Clock Enable (CKE)—Output

The SDRAM clock enable (CKE) signal is an output on the MPC8245 (and is also used as a reset configuration input signal). CKE is part of the SDRAM command encoding. See Section 6.2, “SDRAM Interface Operation,” for more information. The state meaning and timing comments for the CKE output signal are the following:

State Meaning Asserted: Enables the internal clock circuit of the SDRAM memory device.

Negated: Disables the internal clock circuit of the SDRAM memory device.

Timing Comments Assertion: See the *MPC8245 Integrated Processor Hardware Specifications* for more timing information. Also, see Section 6.2, “SDRAM Interface Operation,” for more information.

2.2.2.13 SDRAM Row Address Strobe ($\overline{\text{SDRAS}}$)—Output

The SDRAM row address strobe ($\overline{\text{SDRAS}}$) signal is an output on the MPC8245. The state meaning and timing comments for the $\overline{\text{SDRAS}}$ output signal are the following:

State Meaning Asserted/Negated: $\overline{\text{SDRAS}}$ is part of the SDRAM command encoding and is used for SDRAM bank selection during read or write operations. See Section 6.2, “SDRAM Interface Operation,” for more information.

Timing Comments Assertion: See the *MPC8245 Integrated Processor Hardware Specifications* for more timing information.

2.2.2.14 SDRAM Column Address Strobe ($\overline{\text{SDCAS}}$)—Output

The SDRAM column address strobe ($\overline{\text{SDCAS}}$) signal is an output on the MPC8245. The state meaning and timing comments for the $\overline{\text{SDCAS}}$ output signal are the following:

State Meaning Asserted: $\overline{\text{SDCAS}}$ is part of the SDRAM command encoding and is used for SDRAM column selection during read or write operations. See Section 6.2, “SDRAM Interface Operation,” for more information.

Negated: $\overline{\text{SDCAS}}$ is part of SDRAM command encoding used for SDRAM column selection during read or write operations.

Timing Comments Assertion: See the *MPC8245 Integrated Processor Hardware Specifications* for more timing information.

2.2.2.15 ROM Bank Selects ($\overline{\text{RCS}}$[0:3])—Output

The ROM bank select ($\overline{\text{RCS}}$[0:3]) signals are output on the MPC8245 (and $\overline{\text{RCS0}}$ is a reset configuration input signal). Note that $\overline{\text{RCS2}}$ and $\overline{\text{RCS3}}$ are multiplexed with the TRIG_IN and TRIG_OUT signals, respectively. The state meaning and timing comments for the $\overline{\text{RCS}}$[0:3] output signals are the following:

State Meaning Asserted: Select ROM bank 0–3 for a read access or Flash bank 0–3 for a read or write access.

Negated: Deselect bank 0–3, indicating no pending memory access to ROM/Flash.

Timing Comments Assertion: The MPC8245 asserts $\overline{\text{RCS}}$[0:3] at the start of a ROM/Flash access cycle.

Negation: Controlled by the many timing parameters in ERCR1–4 and MCCR1–2 registers.

2.2.2.16 Flash Output Enable ($\overline{\text{FOE}}$)—Output

The Flash output enable ($\overline{\text{FOE}}$) signal is an output on the MPC8245 (and a reset configuration input signal). The state meaning and timing comments for the $\overline{\text{FOE}}$ output signal are the following:

State Meaning Asserted: Enables Flash output for the current read access.

Negated: Indicates no current read access to Flash.

Note that the $\overline{\text{FOE}}$ signal provides no indication of any write operation(s) to Flash.

Timing Comments Assertion: The MPC8245 asserts $\overline{\text{FOE}}$ at the start of the Flash read cycle.

Negation: Controlled by the many timing parameters in ERCR1–4 and MCCR1–2 registers.

2.2.2.17 Address Strobe ($\overline{\text{AS}}$)—Output

The $\overline{\text{AS}}$ output signal functions as a user-defined timing signal for the Port X interface. The assertion and pulse width are fully programmable with the ASFALL and ASRISE parameters in the MCCR2 register and other timing parameters in the ERCR1–4 and MCCR1–2 registers. $\overline{\text{AS}}$ is also a reset configuration input signal.

State Meaning Asserted: Programmable number of clocks (ASFALL) from the assertion of $\overline{\text{RCS}}$[0:3].

Negated: Programmable number of clocks (ASRISE) from the assertion of $\overline{\text{AS}}$.

2.2.2.18 ROM/Port X Data Ready ($\overline{\text{DRDY}}$)—Input

The $\overline{\text{DRDY}}$ input signal is used as a handshake signal for the Port X interface in the Port X strobe mode or handshake mode. In strobe mode, $\overline{\text{DRDY}}$ can terminate a Port X transaction prematurely. In handshake mode, $\overline{\text{DRDY}}$ must be asserted to terminate a Port X transaction.

State Meaning Asserted: The addressed Port X device has data ready and is signalling that the transaction can be terminated.

Negated: No device is on the Port X interface (in strobe or handshake mode) signalling the end of a transaction.

2.2.3 PIC Control Signals

Five PIC interrupt control signals have dual functions. The signals serve as five distinct incoming interrupt requests (IRQ[0:4]) when the PIC unit is in discrete interrupt mode (defined by GCR[M] = 1 and ICR[SIE] = 0). When the PIC unit is in the serial interrupt mode (GCR[M] = 1 and ICR[SIE] = 1) or pass-through mode (GCR[M] = 0), each signal takes on an alternate function. The protocol for the various modes of the PIC unit are described in Chapter 11, “Programmable Interrupt Controller (PIC) Unit.”

2.2.3.1 Discrete Interrupt 0–4 (IRQ[0:4])—Input

The state meaning for the IRQ[0:4] signals (discrete interrupt mode) follows; the polarity and sense of each of these signals is programmable. All of these inputs can be driven completely asynchronously. In pass-through mode, interrupts from external source IRQ0 are passed directly to the processor.

State Meaning Asserted/Negated: When the interrupt signal is asserted (according to the programmed polarity), the PIC unit the priority checks the priority and the interrupt is conditionally passed to the processor, as Chapter 11, “Programmable Interrupt Controller (PIC) Unit” describes.

2.2.3.2 Serial Interrupt Mode Signals

The serial interrupt mode provides for 1-16 interrupts to be clocked in serially through the S_INT signal. The relative timing for these signals is described in Section 11.6.1, “Sampling of Serial Interrupts.”

2.2.3.2.1 Serial Interrupt Stream (S_INT)—Input

This signal represents the incoming interrupt stream in serial interrupt mode.

State Meaning Asserted/Negated: Represents the interrupts for up to 16 external interrupt sources with individually programmable sense and polarity. The S_CLK signal clocks these interrupts in to the MPC8245.

2.2.3.2.2 Serial Interrupt Clock (S_CLK)—Output

This output serves as the serial clock that the external interrupt source must use for driving the 16 interrupts onto the S_INT signal.

State Meaning Asserted/Negated: The frequency of this clock signal is programmed in the serial interrupt configuration register.

2.2.3.2.3 Serial Interrupt Reset (S_RST)—Output

The state meaning of the S_RST signal is the following:

State Meaning Asserted/Negated: S_RST is asserted only once for two S_CLK cycles when the PIC is programmed to the serial interrupt mode.

2.2.3.2.4 Serial Interrupt Frame ($\overline{\text{S_FRAME}}$)—Output

The state meaning of the $\overline{\text{S_FRAME}}$ signal is the following:

State Meaning Asserted/Negated: Synchronizes the serial interrupt sampling to interrupt source 00.

2.2.3.3 Local Interrupt ($\overline{\text{L_INT}}$)—Output

The state meaning of the $\overline{\text{L_INT}}$ signal is the following:

State Meaning Asserted/Negated: When the PIC is programmed in pass-through mode, this output reflects the raw interrupts that the on-chip MU, I^2C, DUART, and DMA controllers and the PIC timers generate.

2.2.4 I^2C Interface Control Signals

These two signals serve as a communication interconnect with other devices. All devices connected to these two signals must have open-drain or open-collector outputs. The logic AND function is performed on both of these signals with external pull-up resistors. Refer to the *MPC8245 Integrated Processor Hardware Specifications* for the electrical characteristics of these signals.

Chapter 10, “I2C Interface,” has a complete description of the I^2C protocol and the relative timings of the I^2C signals.

2.2.4.1 Serial Data (SDA)

This signal is an input when the MPC8245 is in a receiving mode and an output when it is transmitting (as an I^2C master or a slave).

2.2.4.1.1 Serial Data (SDA)—Output

The state meaning of the SDA output signal when the MPC8245 is transmitting (as an I^2C master or a slave) is the following:

State Meaning Asserted/Negated: Drives the data.

2.2.4.1.2 Serial Data (SDA)—Input

The state meaning of the SDA input signal when the MPC8245 is receiving data is the following:

State Meaning Asserted/Negated: Used to receive data from other devices. The bus is assumed to be busy when SDA is detected low.

2.2.4.2 Serial Clock (SCL)

This signal is an input when the MPC8245 is programmed as an I^2C slave and an output when programmed as an I^2C master.

2.2.4.2.1 Serial Clock (SCL)—Output

The state meaning of the SCL output signal when the MPC8245 is an I^2C master is the following:

State Meaning Asserted/Negated: Driven along with SDA as the clock for the data.

2.2.4.2.2 Serial Clock (SCL)—Input

The state meaning of the SCL output signal when the MPC8245 is an I^2C slave is the following:

State Meaning Asserted/Negated: The I^2C unit uses this signal to synchronize incoming data on SDA. The bus is assumed to be busy when this signal is detected low.

2.2.5 DUART Signals

The DUART unit can be used in either the four-signal UART mode or the special four-signal DUART mode. In the four-signal UART mode, only UART1 is available and the following signals are used: SOUT1, $\overline{\text{CTS1}}$, SIN1, $\overline{\text{RTS1}}$.

In the special four-signal DUART mode, only two signals (SINx and SOUTx) are used for each UART. The signals SIN1, SOUT1, SIN2/$\overline{\text{CTS1}}$, and SOUT2/$\overline{\text{RTS1}}$ are multiplexed with PCI_CLK0, PCI_CLK1, PCI_CLK2, and PCI_CLK3, respectively. Note that when using DUART signals, PCI_CLK[0:3] signals cannot be used.

2.2.5.1 DUART Serial In Data (SIN1, SIN2)—Input

The state meaning of the SINx DUART input signals is the following:

State Meaning Asserted/Negated: Represents data received on the UARTx receiver, with the least significant bit received first.

2.2.5.2 DUART Serial Out Data (SOUT1, SOUT2)—Output

The state meaning of the SOUTx DUART output signals is the following:

State Meaning Asserted/Negated: Represents data transmitted by UARTx. The UARTx transmitter serial data output signals are high (mark condition) when the transmitter is disabled, idle, or operating in the local loop back mode. Data is shifted out on this signal, with the least significant bit transmitted first.

2.2.5.3 Clear to Send ($\overline{\text{CTS1}}$)—Input

The state meaning of the $\overline{\text{CTS1}}$ input signal is the following:

State Meaning Asserted/Negated: This active-low input is the clear-to-send input. It is connected to the $\overline{\text{RTS}}$ output of the external UART device on the bus. $\overline{\text{CTS1}}$ can be programmed to generate an interrupt when the signal changes state.

2.2.5.4 Receive to Send ($\overline{\text{RTS1}}$)—Output

The state meaning of the $\overline{\text{RTS1}}$ output signal is the following:

State Meaning Asserted/Negated: This active-low output is the receive-to-send output, and can be programmed to be negated or asserted. When connected to the clear-to-send ($\overline{\text{CTS}}$) input of an external device, this signal can control data flow as a ready-to-send/receive data indication.

2.2.6 System Control and Power Management Signals

The following sections describe the system control and power management signals of the MPC8245.

2.2.6.1 Hard Reset

The two hard reset signals on the MPC8245 ($\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$) must be asserted and negated together to guarantee normal operation. Together, $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$ cause the MPC8245 to end all current internal and external transactions, and set all registers to their default values. Although $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$ must be asserted together, they may be asserted completely asynchronously with respect to all other signals. See Section 14.2.1, “System Reset,” for a complete description of the reset functionality.

2.2.6.1.1 Hard Reset (Processor) ($\overline{\text{HRST_CPU}}$)—Input

The following describes the state meaning and timing for the $\overline{\text{HRST_CPU}}$ input signal.

State Meaning Asserted/Negated: See Section 2.1.2, “Output Signal States During Reset,” and Section 2.4, “Configuration Signals Sampled at Reset,” for more information about the interpretation of the other MPC8245 signals during reset.

Timing Comments Assertion/Negation: See the *MPC8245 Integrated Processor Hardware Specifications* for specific timing information of these signals and the reset configuration signals.

2.2.6.1.2 Hard Reset (Peripheral Logic) ($\overline{\text{HRST_CTRL}}$)—Input

The following describes the state meaning and timing for the $\overline{\text{HRST_CTRL}}$ input signal. Note that this signal corresponds to the RST# signal of the PCI specification.

State Meaning Asserted/Negated: See Section 2.1.2, “Output Signal States During Reset”, and Section 2.4, “Configuration Signals Sampled at Reset,” for more information about the interpretation of the other MPC8245 signals during reset.

Timing Comments Assertion/Negation: See the *MPC8245 Integrated Processor Hardware Specifications* for specific timing information of these signals and the reset configuration signals.

2.2.6.2 Soft Reset ($\overline{\text{SRESET}}$)—Input

The assertion of the soft reset input signal causes the same actions as the assertion of the internal *sreset* signal by the PIC unit. A soft reset is recoverable, provided that in attempting to reach a recoverable state, the processor does not encounter a machine check condition. A soft reset exception is third in priority, following a hard reset and machine check. Note that the $\overline{\text{SRESET}}$ signal is multiplexed with the SDMA12 signal. In extended addressing mode, SDMA12 is used and $\overline{\text{SRESET}}$ is not available. See 6.3.2, “Extended ROM Interface,” for more information.

State Meaning Asserted/Negated: When $\overline{\text{SRESET}}$ is asserted, the processor core attempts to reach a recoverable state by allowing the next instruction to either complete or cause an exception, blocking the completion of subsequent instructions, and allowing the completed store queue to drain. Unlike a hard reset, no registers or latches are initialized; however, the instruction cache is disabled (HID0[ICE] = 0].

Timing Comments Assertion: May occur at any time, asynchronous to any clock.
Negation: Must be asserted for at least 2 *sys_logic_clk* cycles. After $\overline{\text{SRESET}}$ is negated, the processor vectors to the system reset vector.

2.2.6.3 Machine Check ($\overline{\text{MCP}}$)—Output

The MPC8245 drives the $\overline{\text{MCP}}$ signal when any of the conditions described in Chapter 14, “Error Handling,” generate a machine check error for generating the internal $\overline{mcp}$ signal. The assertion of $\overline{\text{MCP}}$ depends upon whether the error handling registers of the MPC8245 are set to report the specific error. Additionally, the programmable parameter PICR1[MCP_EN] enables or disables the assertion of $\overline{\text{MCP}}$ by the MPC8245 for all error conditions. $\overline{\text{MCP}}$ is also used as a reset configuration input signal.

NOTE

Set the MIOCR[MCP_OD_MODE] parameter to designate the output driver for $\overline{\text{MCP}}$ as open-drain.

State Meaning Asserted: Reflects the state of the internal $\overline{mcp}$ signal. Indicates that a reportable error condition, as defined in Chapter 14, “Error Handling,” occurred. The current transaction may or may not have ended, depending upon the software configuration. Assertion of $\overline{mcp}$ causes the processor core to take a machine check exception conditionally or enter the checkstop state based on the setting of the MSR[ME] bit in the processor core.

Negated: No $\overline{mcp}$ is being reported to the processor core.

Timing Comments Assertion: $\overline{mcp}$ may be asserted to the processor core in any cycle. The same timing applies to $\overline{\text{MCP}}$.

Negation: The MPC8245 holds $\overline{mcp}$ asserted until the processor core has taken the exception and all the error flags are cleared. The MPC8245 decodes a machine check acknowledge cycle by detecting processor reads from the two possible machine check exception addresses at 0x0000_0200–0x0000_0207 and 0xFFF0_0200–0xFFF0_0207 and then negates $\overline{mcp}$. This timing also applies to $\overline{\text{MCP}}$.

High impedance: If the MIOCR[MCP_OD_MODE] bit is set, the $\overline{\text{MCP}}$ signal is placed in high impedance when there is no error to report.

2.2.6.4 Nonmaskable Interrupt (NMI)—Input

The nonmaskable interrupt (NMI) signal is an input on the MPC8245. The state meaning and timing comments for the NMI input signal follow in this section. See Chapter 14, "Error Handling," for more information.

State Meaning Asserted: Indicates that the MPC8245 should signal a machine check interrupt ($\overline{mcp}$) to the processor core.

Negated: No NMI reported.

Timing Comments Assertion: NMI may occur asynchronously at any time.

Negation: Should not occur until after the interrupt is taken. (The interrupt source is assumed to be cleared by software in the interrupt handler routine).

2.2.6.5 System Management Interrupt ($\overline{\text{SMI}}$)—Input

The state meaning and timing comments for $\overline{\text{SMI}}$ are the following:

State Meaning Asserted: The $\overline{\text{SMI}}$ input signal is level-sensitive and causes exception processing for a system management interrupt when $\overline{\text{SMI}}$ is asserted and MSR[EE] is set.

Negated: Indicates that normal operation should proceed.

Timing Comments Assertion: May occur at any time and may be asserted asynchronously to the input clocks.

Negation: Should not occur until the interrupt is taken.

2.2.6.6 Checkstop In ($\overline{\text{CHKSTOP_IN}}$)—Input

The state meaning and timing comments for the $\overline{\text{CHKSTOP_IN}}$ signal follow. Note that the $\overline{\text{CHKSTOP_IN}}$ signal is multiplexed with the SDMA14 signal. In extended addressing mode, SDMA14 is used and $\overline{\text{CHKSTOP_IN}}$ is not available. See 6.3.2, "Extended ROM Interface," for more information.

State Meaning Asserted: Indicates that the MPC8245 processor core must internally gate off all clocks and release all processor-related outputs to the high-impedance state to terminate operation.

Negated: Indicates that normal operation should proceed.

Timing Comments Assertion: May occur at any time, and may be asserted asynchronously to the input clocks.

Negation: Must remain asserted until the system is reset with a hard reset.

2.2.6.7 Time Base Enable (TBEN)—Input

The state meaning and timing comments for TBEN follow. Note that the TBEN signal is multiplexed with the SDMA13 signal. In extended addressing mode, SDMA13 is used and TBEN is not available. In this case, PICR1[DEC] can be used to enable the processor core's decrementer. See Table 4-30 for a description of PICR1[DEC].

State Meaning Asserted: Indicates that the time base and decrementer should continue clocking. This input is essentially a count-enable control for the time base counter and the decrementer.

Negated: Indicates that the time base and decrementer should stop clocking.

Timing Comments Assertion/Negation: May occur on any cycle.

2.2.6.8 Quiesce Acknowledge ($\overline{\text{QACK}}$)—Output

The quiesce acknowledge ($\overline{\text{QACK}}$) signal is an output on the MPC8245 and is also a reset configuration input signal. See Chapter 15, "Power Management," for more information about the power management signals. The state meaning and timing comments for the $\overline{\text{QACK}}$ output signal are the following:

State Meaning Asserted: Indicates that the processor core and peripheral logic are in either nap or sleep mode.

Negated: Indicates that the processor core and peripheral logic are not in nap or sleep mode.

2.2.6.9 Watchpoint Trigger Signals

One watchpoint trigger input and one watchpoint trigger output signal together provide a programmable output signal and control of the watchpoint facility. See Chapter 18, "Programmable I/O and Watchpoint," for more information about the watchpoint facility.

2.2.6.9.1 Watchpoint Trigger In (TRIG_IN)—Input

The watchpoint trigger in (TRIG_IN) signal is an input on the MPC8245. The state meaning and timing comments for the TRIG_IN signal follow in this section. Note that TRIG_IN is an active-high (rising-edge triggered) signal that can be used alternately as the $\overline{\text{RCS2}}$ output signal.

State Meaning Asserted: May cause the MPC8245 to exit the HOLD state or may cause the value of the WP_RUN bit in the WP_CONTROL register

to toggle (turning the watchpoint facility on or off). See Chapter 18, “Programmable I/O and Watchpoint,” for more information.

Negated: No action taken.

Timing Comments Assertion/Negation: The MPC8245 interprets TRIG_IN as asserted on detection of the rising edge of TRIG_IN. Required to be asserted for a single clock cycle only.

2.2.6.9.2 Watchpoint Trigger Out (TRIG_OUT)—Output

The watchpoint trigger out (TRIG_OUT) signal is an output on the MPC8245. The state meaning and timing comments for the TRIG_OUT signal follow in this section. Note that the setting of WP_CONTROL[WP_TRIG] controls the active sense of TRIG_OUT. It can be used alternately as the $\overline{\text{RCS2}}$ output signal.

State Meaning Asserted: Indicates that a final watchpoint match occurred, as defined in the WP_MODE field of the WP_CONTROL register.

Negated: No final watchpoint match condition.

Timing Comments Assertion/Negation: Asserted until TRIG_IN is asserted unless the WP_TRIG_HOLD parameter in the WP_CONTROL register is cleared. Then TRIG_OUT is asserted for a single clock cycle.

2.2.6.10 Debug Signals

The following sections describe the debug signals that the MPC8245 uses in various debug modes. See Chapter 17, “Debug Features,” for more details and timing information about the debug signals.

2.2.6.10.1 Memory Address Attributes (MAA[0:2])—Output

The memory attribute signals are associated with the memory interface and provide information about the source of the memory operation that the MPC8245 is performing. They are also reset configuration input signals.

State Meaning Asserted/Negated: These signals are encoded to provide more detailed information about a memory transaction. See Section 17.2.1, “Memory Address Attribute Signals (MAA[0:2]),” for a table showing these encodings.

Timing Comments Assertion/Negation: Section 17.2.2, “Memory Address Attribute Signal Timing,” refers to timing diagrams that show the relative timing of these signals and the rest of the memory interface.

2.2.6.10.2 PCI Address Attributes (PMAA[0:2])—Output

The memory attribute signals are associated with the PCI interface and provide information about the source of the PCI operation that the MPC8245 is performing. They are also reset configuration input signals.

State Meaning Asserted/Negated: These signals are encoded to provide more detailed information about a PCI transaction. See Section 17.2.3, “PCI Address Attribute Signals,” for a table showing these encodings.

Timing Comments Assertion/Negation: Section 17.2.4, “PCI Address Attribute Signal Timing,” contains timing diagrams showing the relative timing of these signals and the rest of the PCI interface.

2.2.6.10.3 Debug Address (DA[0:15])—Output

When enabled, the debug address provides software disassemblers a simple way to reconstruct the 30-bit physical address for a memory bus transaction to SDRAM, ROM, Flash, or Port X. Note that most of these signals are multiplexed with other signals that may be inputs in their alternate function.

State Meaning Asserted/Negated: Section 17.3.1, “Enabling Debug Address,” describes these signals in detail, and documents how they are mapped to different address bits, depending on the type of memory in use.

Timing Comments Assertion/Negation: For SDRAM, these 16 debug address signals are sampled with the chip-selects. For ROM, Flash, and Port X devices, the debug address pins are sampled at the same time as the ROM address and can be used to recreate the 24-bit physical address with ROM address.

2.2.6.10.4 Memory Interface Valid ($\overline{\text{MIV}}$)—Output

Signalling when address and data signals should be sampled, the $\overline{\text{MIV}}$ signal can help reduce the number of bus cycles that logic analyzers must store in memory during a debug trace.

State Meaning Asserted: The memory interface valid signal, $\overline{\text{MIV}}$, is asserted whenever SDRAM, Flash, or ROM addresses or data are present on the external memory bus.

Timing Comments Assertion/Negation: Section 17.4.1, “MIV Signal Timing,”describes the relative timing of $\overline{\text{MIV}}$ in detail.

2.2.7 Test and Configuration Signals

The MPC8245 has several signals that are sampled during reset to determine the configuration of the phase-locked loop clock mode and the ROM, Flash, and dynamic memory.

To facilitate system testing, the MPC8245 provides a JTAG test access port (TAP) that complies with the IEEE 1149.1 boundary-scan specification. This section also describes the JTAG test access port signals.

2.2.7.1 PLL Configuration (PLL_CFG[0:4])—Input

PLL_CFG[0:4] determine the clock frequency relationships of the PCI clock, the processor core frequency, and the *sys_logic_clk* signal that determines the frequency of the memory interface clock. The value of PLL_CFG[0:4] at reset time is stored in the AMBOR register and is readable from this register. See Section 4.10, “Address Map B Options Register—0xE0,” for more information. Also, the multiplier factor that these signals determine on reset is stored in HID1[PLLRATIO]. See Section 5.3.1.2.2, “Hardware Implementation-Dependent Register 1 (HID1),” for more information about HID1.

State Meaning Asserted: See the *MPC8245 Integrated Processor Hardware Specifications* for the supported settings.

Timing Comments Assertion: These signals are sampled a few clocks after the negation of $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$. See the *MPC8245 Integrated Processor Hardware Specifications* for timing information.

2.2.7.2 JTAG Test Clock (TCK)—Input

The JTAG test clock (TCK) signal is an input on the MPC8245. The state meaning for the TCK input signal is the following:

State Meaning Asserted/Negated: A free-running clock signal with a 30–70% duty cycle should drive this input. Input signals to the test access port are clocked in on the rising edge of TCK. Changes to the test access port output signals occur on the falling edge of TCK. The test logic allows TCK to be stopped.

Note that this input contains an internal pull-up resistor to ensure that an unterminated input appears as a high signal level to the test logic.

2.2.7.3 JTAG Test Data Input (TDI)—Input

The state meaning for the TDI input signal is the following:

State Meaning Asserted/Negated: The value presented on this signal on the rising edge of TCK is clocked into the selected JTAG test instruction or data register.

Note that this input contains an internal pull-up resistor to ensure that an unterminated input appears as a high signal level to the test logic.

2.2.7.4 JTAG Test Data Output (TDO)—Output

The state meaning for the TDO output signal is the following:

State Meaning Asserted/Negated: The contents of the selected internal instruction or data register are shifted out onto this signal on the falling edge of TCK. The TDO signal remains in a high-impedance state except when data scanning is in progress.

2.2.7.5 JTAG Test Mode Select (TMS)—Input

The test mode select (TMS) signal is an input on the MPC8245. The state meaning for the TMS input signal is the following:

State Meaning Asserted/Negated: To distinguish the primary operation of the test support circuitry, the internal JTAG TAP controller decodes this signal.

Note that this input contains an internal pull-up resistor to ensure that an unterminated input appears as a high signal level to the test logic.

2.2.7.6 JTAG Test Reset ($\overline{\text{TRST}}$)—Input

The test reset ($\overline{\text{TRST}}$) signal is an input on the MPC8245. The state meaning for the $\overline{\text{TRST}}$ input signal is the following:

State Meaning Asserted: This input causes asynchronous initialization of the internal JTAG test access port controller. Note that the signal must be asserted during power-up reset to initialize the JTAG test access port properly and to support normal operation of the MPC8245.

Negated: Indicates normal operation.

NOTE

This input contains an internal pull-up resistor to ensure that an unterminated input appears as a high signal level to the test logic.

2.2.8 Clock Signals

The MPC8245 coordinates clocking across the memory bus and the PCI bus. This section provides a brief description of the MPC8245 clock signals. See Section 2.3, “Clocking,” for more detailed information about using the MPC8245 clock signals.

2.2.8.1 System Clock Input (OSC_IN)—Input

Provides the input to the PCI clock fanout buffer. A clock can be connected to this input to provide multiple low-skew copies on the PCI_CLK[0:4] and PCI SYNC_OUT signals. For systems that do not use the fanout buffer feature, this signal should be tied to a fixed state.

2.2.8.2 PCI Clock (PCI_CLK[0:4])—Output

These signals provide multiple copies of OSC_IN as output signals when using the PCI clock fanout buffer feature. If these outputs are not needed, they can be individually disabled in the CDCR register to minimize power consumption. Note that PCI_CLK[0:3] cannot be used when using DUART signals SIN1, SOUT1, SIN2/$\overline{\text{CTS1}}$, and SOUT2/$\overline{\text{RTS1}}$.

2.2.8.3 PCI Clock Synchronize Out (PCI_SYNC_OUT)—Output

This output is an additional clock that the PCI clock fanout buffer provides. It is intended to be fed into the PCI_SYNC_IN signal to allow the internal clock subsystem to synchronize to the system PCI clocks.

2.2.8.4 PCI Feedback Clock (PCI_SYNC_IN)—Input

This signal provides the reference clock input to the peripheral logic PLL. The PLL multiplies up and synchronizes to this reference clock. The frequency of the PLL outputs is based on the PLL clock frequency configuration signal settings at reset. See the *MPC8245 Integrated Processor Hardware Specifications* for a complete listing of supported PLL_CFG[0:4] settings.

2.2.8.5 SDRAM Clock Outputs (SDRAM_CLK[0:3])—Output

The MPC8245 provides four low-skew copies of the SDRAM clock to use in small memory subsystems. This clock is synchronized to the on-chip logic using a DLL. If these outputs are not needed, they can be individually disabled in the CDCR register to minimize power consumption.

2.2.8.6 SDRAM Clock Synchronize Out (SDRAM_SYNC_OUT)—Output

SDRAM_SYNC_OUT is an additional SDRAM clock similar to SDRAM_CLK[0:3] and can allow feedback into the DLL to allow proper compensation for the output and flight time delay of the clock path.

2.2.8.7 SDRAM Feedback Clock (SDRAM_SYNC_IN)—Input

SDRAM_SYNC_IN is a feedback clock for the DLL to perform the phase comparison with respect to *sys_logic_clk*, which adjusts the amount of delay for all the SDRAM_CLK[0:3] signals.

The SDRAM_SYNC_OUT signal should be connected to the SDRAM_SYNC_IN signal to allow the on -chip DLL to synchronize and compensate for routing delays and the output buffer. When the DLL is locked, SDRAM_SYNC_IN is in phase with *sys_logic_clk*.

For systems that use an external PLL to provide the clock source to SDRAM, this signal can be pulled high unless the SDRAM clock-to-PCI clock ratio is non-integer (3:2 or 5:2). In that case, this signal can synchronize between the internal clock and the external SDRAM clock.

2.2.8.8 Debug Clock (CKO)—Output

The debug clock (CKO) signal is an output on the MPC8245. The internal signal reflected on CKO is determined by either the HID0[ECLK,SBCLK] bits (if PMCR1[CKO_SEL] = 0), or the two-bit PMCR1[CKO_MODE] field (if PMCR1[CKO_SEL] = 1). Both of these options allow the CKO output driver to be disabled. See Section 5.3.1.2.1, “Hardware Implementation-Dependent Register 0 (HID0),” and Section 4.3.1, “Power Management Configuration Register 1 (PMCR1)—Offset 0x70,” for more information.

Note that as described in Section 5.3.1.2.1, “Hardware Implementation-Dependent Register 0 (HID0)”, the processor core clock is driven on CKO while $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$ are asserted.

The signal on this output is derived from a variety of internal signals after passing through different numbers of internal buffers. This signal is intended for use during system debug, rather than as a reference clock signal.

2.3 Clocking

The following sections describe the clocking on the MPC8245.

2.3.1 Clocking Method

The MPC8245 allows for multiple clock options to suit the needs of various system configurations. Internally, the MPC8245 uses a phase-locked loop (PLL) circuit to generate master clocks to the system logic and a second PLL to generate the processor clock. The system logic PLL is synchronized to the PCI_SYNC_IN input signal.

Figure 2-2 shows a block diagram of the clocking signals in the MPC8245.

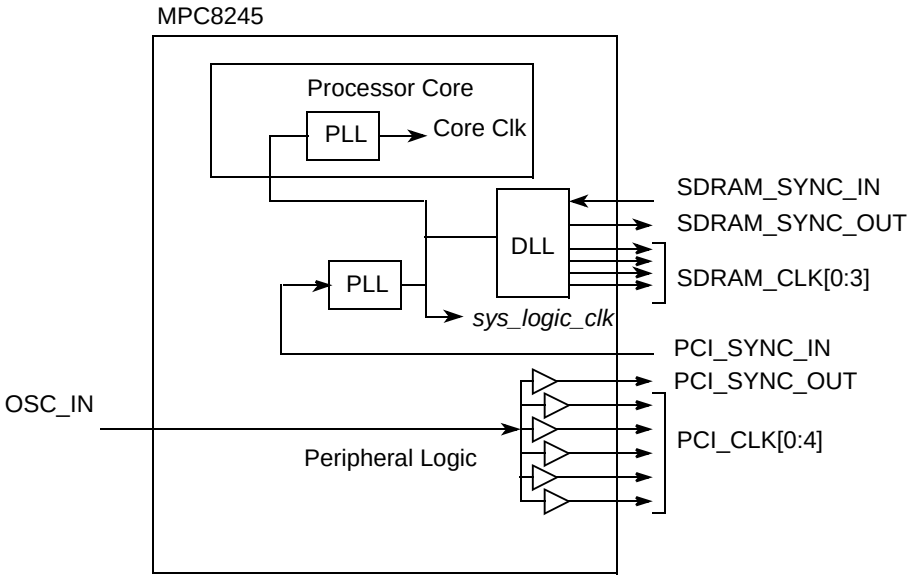


Figure 2-2. Clock Subsystem Block Diagram

The *sys_logic_clk* signal may be set to a multiple of the PCI bus frequency as defined in the *MPC8245 Integrated Processor Hardware Specifications*. To help reduce the amount of discrete logic required in a system, the MPC8245 provides PCI clock fanout buffers. The MPC8245 also provides the memory clock (SDRAM_CLK*n*) signals through a delay locked loop (DLL) that is running at the same frequency as the internal system logic (*sys_logic_clk*).

Figure 2-3 shows the relationship of PCI_SYNC_IN and some multiplied clocks.

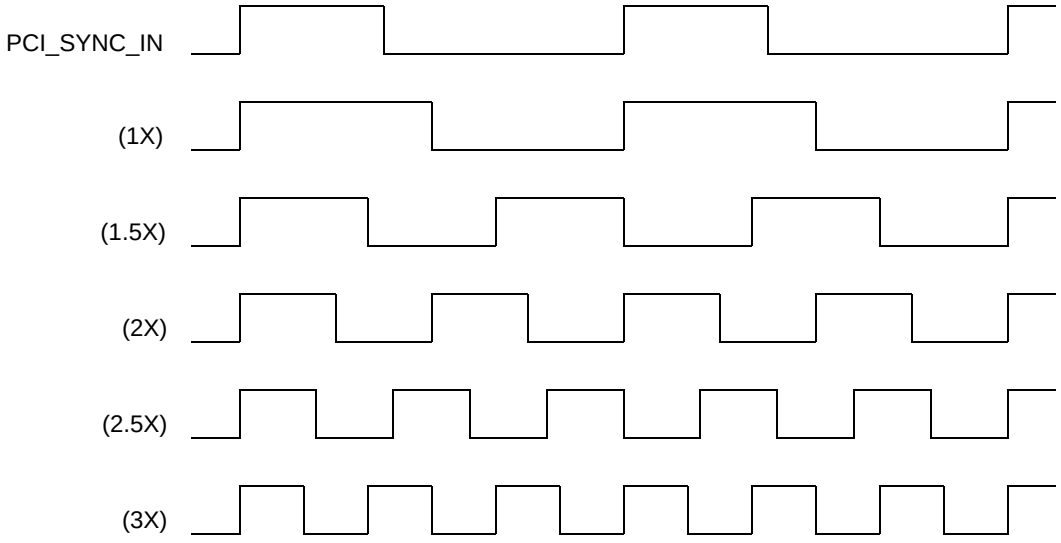


Figure 2-3. Timing Diagram (1x, 1.5x, 2x, 2.5x, and 3x examples)

NOTE

PCI_SYNC_IN is not required to have a 50% duty cycle. Furthermore, the PLL phase-locks the bus interface clocks, internal clock and PCI_SYNC_IN edges.

T he PLL_CFG[0:4] signals configure the MPC8245 system logic PLL at reset. For a given PCI frequency, these signals set the peripheral logic frequency and PLL (VCO) frequency of operation and determine the available multiplier frequencies for the processor core. The multiplier for the processor's PLL is further defined by PLL_CFG[0:4] and represented by the value in HID1[PLLRATIO]. See Section 5.3.1.2.2, "Hardware Implementation-Dependent Register 1 (HID1)," for more information about HID1. The supported settings for the PLL configuration pins are defined in the *MPC8245 Integrated Processor Hardware Specifications*.

2.3.2 DLL Operation and Locking

The DLL on the MPC8245 generates the SDRAM_CLK[0:3] and SDRAM_SYNC_OUT signals. SDRAM_SYNC_OUT should be fed back through a delay loop into the SDRAM_SYNC_IN input of the MPC8245. Adjusting the length of the delay loop can remove the effects of trace delay to the system memory when the delay through the loop is equivalent to the delay to the system memory.

The peripheral logic DLL is synchronized with SDRAM_SYNC_IN as follows:

1. PCI_CLK_SYNC_IN defines the phase.
2. The PLL generates *sys_logic_clk*, which eventually is in phase with PCI_SYNC_IN.
3. The DLL causes SDRAM_SYNC_IN to be in phase eventually with *sys_logic_clk*.

Note that if the DLL is not yet locked, SDRAM_SYNC_IN probably shifts (*sys_logic_clk* does not shift) as the DLL adds/subtracts delay from SDRAM_SYNC_OUT, until it locks. Thus, when the DLL is locked, SDRAM_SYNC_IN is in phase with *sys_logic_clk*, which in turn is in phase with PCI_SYNC_IN.

Figure 2-2 shows how the PCI_SYNC_IN and SDRAM_SYNC_IN signals are independent of each other. These signals are supplied for synchronization of external components on the system board. For minimum skew between PCI_SYNC_OUT and the PCI_CLK*n* signals, design the trace length on PCI_SYNC_IN so that it is the same as the trace lengths on the PCI_CLK*n* signals to their driven components. Similarly, for minimum skew, design the loop length on SDRAM_SYNC_IN so that it is the same as the loop lengths on the SDRAM_CLK*n* signals to their driven components. For example, for minimum skew, if an SDRAM device has a 5-inch trace, the loop trace should be five inches long.

NOTE

Note that a system designer may deliberately vary the loop lengths to introduce a distinct amount of skew between SDRAM_SYNC_OUT (PCI_SYNC_OUT) and the SDRAM_CLKn (PCI_CLKn) signals.

To ensure proper operation and successful locking of the DLL, meet the requirements that the *MPC8245 Integrated Processor Hardware Specifications* describes. In some cases (depending on the board layout and the frequencies), the DLL lock range must be lengthened by setting the MIOCR1[DLL_MAX_DELAY] bit described in Section 4.4, "Output/Clock Driver and Miscellaneous I/O Control Registers." Increase the time between each of the 128 tap points in the delay line. Although this increased time makes it easier to guarantee that the reference clock is within the DLL lock range, it can cause slightly more jitter in the output clock of the DLL if the phase comparator shifts the clock between adjacent tap points.

In some cases, such as systems that do not use the DLL_MAX_DELAY bit to lengthen the DLL lock range and are unable to meet the timing requirements, particularly with a low-speed memory bus, the DLL tap point may need to be altered explicitly. In that case, write the DLL_EXTEND bit of PMCR2 to shift the lock range of the DLL by half of an SDRAM clock cycle. Note that this bit should be written during system initialization only, and should not be altered during normal operation. See *MPC8245 Integrated Processor Hardware Specifications* for more information about using DLL_EXTEND and the locking ranges that MPC8245 supplies.

A bit (DLL_RESET) in the AMBOR register controls the initial tap point of the DLL. Note that although this bit is cleared after a hard reset, it must be explicitly set and then cleared by software during initialization to guarantee correct operation of the DLL and the SDRAM_CLK[0:3] signals (if they are used). See Section 4.10, "Address Map B Options Register—0xE0," for more information about the DLL_RESET bit.

2.3.3 Clock Synchronization

The MPC8245 can provide the entire system with various system clocks based on PCI_SYNC_IN and the PLL_CFG[0:4] setting at reset. The internal logic of the MPC8245 synchronizes all of these clocks. In systems that use an external PLL to generate the memory system clocks and do not depend on the SDRAM_CLK[0:3] signals (shown in Figure 2-4), PCI_SYNC_IN must be phase-aligned with the input to the external PLL. Also, the MPC8245 system logic PLL should be programmed to have the same bus ratio as the external PLL to synchronize the internal processor bus and the internal peripheral logic to the memory interface.

In situations where the setting of PLL_CFG[0:4] creates a half-clock ratio between the PCI bus and processor bus and where an external PLL generates the memory system clocks, SDRAM_SYNC_IN must be driven by the external PLL the same way as the SDRAM

devices. In addition, clock flipping logic must be enabled through the reset configuration pin $\overline{\text{QACK}}$. This flipping ensures that the processor bus and internal logic are synchronized to the external memory system clocks in half-clock modes. Also, enabling the flipping during half-clock modes delays the internal $\overline{\textit{hard_reset}}$ to the processor core by 2^{17}(131,072) processor clock cycles. This delay is required to ensure that the clocking was stabilized inside the MPC8245 after a reset.

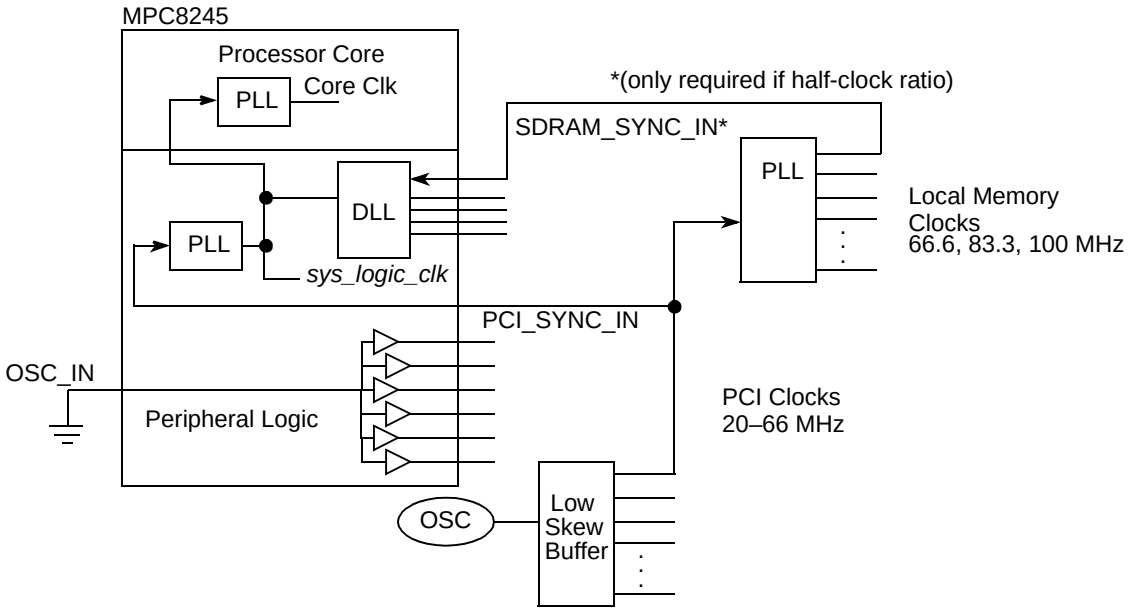


Figure 2-4. System Clocking with External PLL

2.3.4 Clocking System Solution Examples

This section describes two example clocking solutions for different system requirements. For systems where the MPC8245 is the host controller with a minimum number of clock loads, clock fanout buffers are provided on-chip (shown in Figure 2-5). For systems that require more clock fanout or where the MPC8245 is an agent device, use external clock buffers (see Figure 2-6).

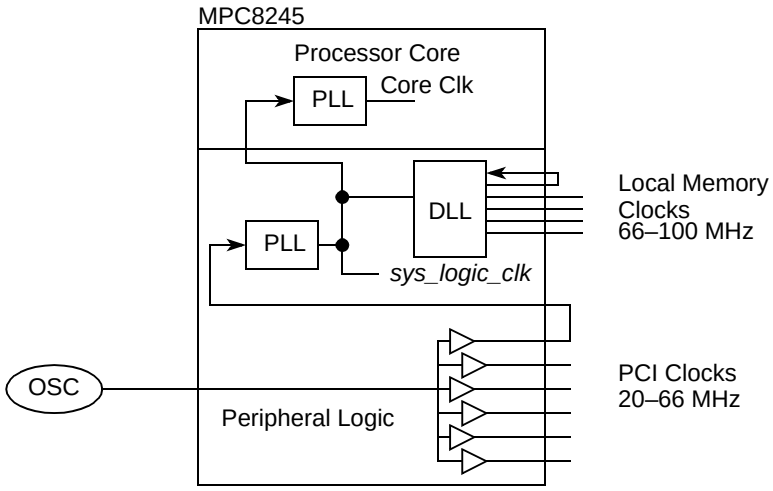


Figure 2-5. Clocking Solution—Small Load Requirements

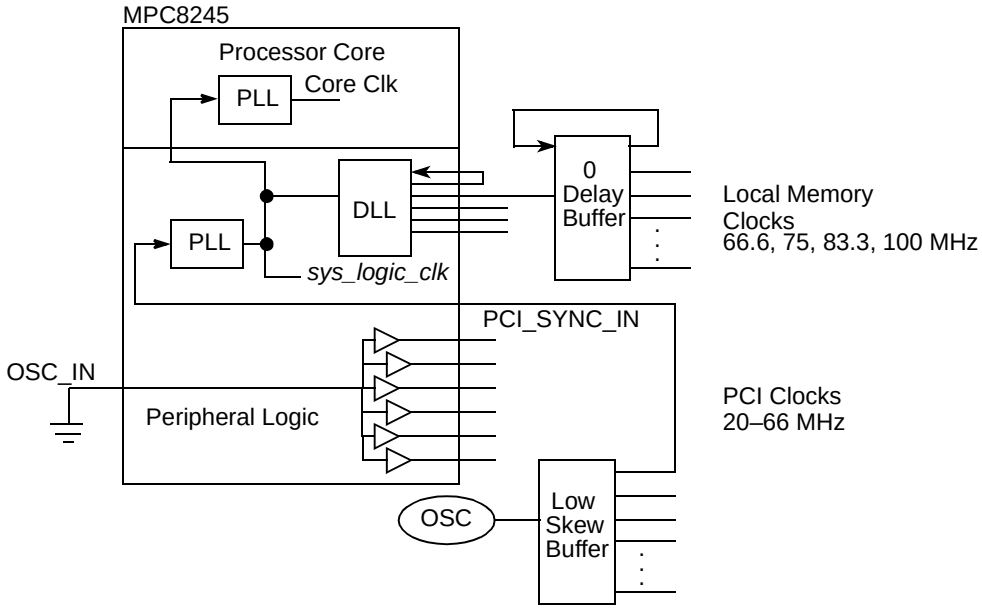


Figure 2-6. Clocking Solution—High Clock Fanout Required

2.4 Configuration Signals Sampled at Reset

Table 2-5 contains a description of the signals sampled for configuration at the negation of the $\overline{\text{HRST_CTRL}}$ and $\overline{\text{HRST_CPU}}$ signals. Note that throughout this manual, the reset configuration signals are described as being sampled at the negation of reset. However, the reset configuration signals are actually sampled three clock cycles before the negation of the $\overline{\text{HRST_CTRL}}$ and $\overline{\text{HRST_CPU}}$ signals, as described in the *MPC8245 Integrated Processor Hardware Specifications.* For more information about the timing requirements of these configuration signals relative to the negation of the reset signals, refer to the *MPC8245 Integrated Processor Hardware Specifications*.

The reset configuration signals serve multiple purposes, and the signal names do not reflect the functionality of the signals as they are used for reset configuration. The values on these signals during reset are interpreted to be logic one or zero, regardless of whether the signal name is defined as active-low. Most of the reset configuration signals have internal pull-up resistors so that if the signals are not driven, the default value is high (a one), as shown in the table. Some signals do not have pull-up resistors and must be driven high or low during the reset period. Note that although the PLL_CFG[0:4] are sampled a few clocks after the negation of HRST_CTRL and HRST_CPU, they are not considered reset configuration signals.

Table 2-5. MPC8245 Reset Configuration Signals

Signal Name	Default	State Meaning
AS	1	Clock out select. Sets the initial value of PMCR1[CKO_SEL]: 0 Processor CKO; value on this signal determined by HID0[ECLK,SBCLK]. 1 Peripheral logic CKO; value on this signal determined by PMCR1[CKO_MODE] field.
MDL[0], FOE	11	Sets the initial ROM bank 0 data path width, DBUS_SIZE[0:1], values in MCCR1. DBUS_SIZE[0:1] = (MDL[0], FOE) at reset. MDL[0] also selects the size of the data interface of the peripheral logic bus (between the processor core and the peripheral logic) with the same settings and meaning as shown for RCS1 below. For ROM/FLASH chip select #0 (RCS0) (MDL[0] = 0, FOE = 0) = 32-bit data bus (MDL[0] = x, FOE = 1) = 8-bit data bus (MDL[0] = 1, FOE = 0) = 64-bit data bus
MAA0	1	Address map setting. This signal should always be pulled high since the MPC8245 only supports address map B. 1 The MPC8245 is configured for address map B.
MAA1	1	MPC8245 host mode 0 MPC8245 is a PCI agent device 1 MPC8245 is a PCI master (host) device
MAA2	1	PCI arbiter disable. The value on this signal is inverted and then written as the initial value of bit 15 in the PCI arbiter control register (PACR). 0 PCI arbiter enabled 1 PCI arbiter disabled
MCP, CKE	11	PCI output hold delay value (in nanoseconds) relative to PCI_SYNC_IN. The values on these two signals determine the initial settings of PMCR2[5:4] as described in Section 4.3.2, “Power Management Configuration Register 2 (PMCR2)—Offset 0x72,” and the *MPC8245 Integrated Processor Hardware Specifications.* Note that the initial value in PMCR2[5:4] is the inverse of the voltages on these signals at the negation of reset (so the default for PMCR2[5:4] = 00).
PMAA0, PMAA1	11	Driver capability for the memory signals (CS[0:7], DQM[0:7], WE, FOE, RCS0, RCS1, SDBA[1:0], SDRAS, SDCAS, CKE, AS, and SDMA[11:0], CHKSTOP_IN, SRESET, TBEN,TRIG_OUT, SDRAM_CLK[0:3], and SDRAM_SYNC_OUT signals). Sets the initial value of the DRV_MEM _CTRL[1–2] bits in ODCR. 00 reserved 01 40-Ω drive capability 10 20-Ω drive capability 11 6-Ω drive capability

Table 2-5. MPC8245 Reset Configuration Signals (continued)

Signal Name	Default	State Meaning
PMAA2	1	Driver capability for the PCI and PIC controller output signals. The value of this signal sets the initial value of ODCR[DRV_PCI]. 0 20 Ω drive capability on AD[31:0], C/BE[3:0], DEVSEL, FRAME, GNT[4:0], PAR, INTA, IRDY, PERR, SERR, STOP, TRDY, IRQ0/S_INT, IRQ1/S_CLK, and IRQ4/L_INT signals and 6 Ω drive capability on IRQ2/S_RST and IRQ3/S_FRAME 1 40 Ω drive capability on PCI/PIC signals
QACK	0	Clock flip disable. When this signal is low on reset, it enables internal clock flipping logic, which is necessary when the PLL[0:4] signals select a half-clock frequency ratio and an external PLL is used to drive the SDRAM device. Note that clock flipping is not required when the MPC8245 supplies the SDRAM clocks, even if half bus ratios are selected. See Section 2.3.3, “Clock Synchronization” for more information about using clock flipping. 0 Clock flip enabled 1 No clock flip
RCS0	1	Boot memory location. The setting of this signal during reset sets the initial RCS0 value in the PICR1 register 0 Indicates that boot ROM is located on the PCI bus. 1 Indicates that boot ROM is located on local processor/memory data bus.
GNT4	1	Debug address disable. Sets the initial value of WP_CONTROL[DEBUG_ADDR_]. See Section 17.3, “Memory Debug Address”, for more information about this function. 0 Debug address enabled; partial address of the transaction driven on DA[0:15]. 1 Debug address disabled
SDMA1	1	Extended addressing mode. When this signal is low during reset, the extended addressing mode is enabled. The value of this signal during reset determines the function of the SRESET, TBEN, CHKSTOP_IN, TRIG_IN, and TRIG_OUT signals. See 6.3.2, “Extended ROM Interface,” for more information about the multiplexing of these signals. 0 Extended addressing mode enabled. SDMA12, SDMA13, SDMA14, RCS2, and RCS3 signals are available. 1 Extended addressing mode disabled. SRESET, TBEN, CHKSTOP_IN, TRIG_IN, and TRIG_OUT are available.
SDMA0	1	DUART signals disabled. Controls the multiplexing between the DUART signals and the PCI_CLK[0:3] signals. When this signal is low during reset, the SOUT1, SIN1, SOUT2/RTS1, and SIN2/CTS1 signals are used instead of the PCI_CLK[0:3] signals. 0 DUART unit signals enabled 1 PCI_CLK[0:3] used instead of the DUART unit signals
MDH[16:31]	x [1]	Sets the initial value of the PCI Subsystem Vendor ID register (at offset 0x2C).
MDH[0:15]	x [2]	Sets the initial value of the PCI Subsystem ID register (at offset 0x2E).

[1] The MDH[16:31] signal should be driven at reset to determine the initial value of the PCI Subsystem Vendor ID, but alternatively 0x2C can be programmed during initialization.

[2] The MDH[0:15] signal should be driven at reset to determine the initial value of the PCI Subsystem ID, but alternatively 0x2E can be programmed during initialization.

Chapter 3
Address Maps

The MPC8245 in PCI host mode supports an address mapping configuration that is designated as address map B. In agent mode, the MPC8245 offers address translation capability to allow address remapping for inbound and outbound PCI memory transactions. Translation allows a certain address space to map to a window of physical memory.

The MAA1 reset configuration pin selects whether the MPC8245 is operating as a PCI host or agent. For more information about the reset configuration signals, see Section 2.4, “Configuration Signals Sampled at Reset.”

The MPC8245 also has a block of local memory and PCI memory space that is allocated to the control and status registers for several embedded features. This block is called the embedded utilities memory block (EUMB). The EUMB and its offsets are also described in this chapter.

3.1 Address Map B

The address space of map B is divided into the following four areas:

- local memory
- PCI memory
- PCI I/O
- system ROM space

Throughout this chapter, the term *local memory* means that the MPC8245 memory controller directly controls SDRAM.

Table 3-1, Table 3-2, Table 3-3, and Table 3-4 show separate views of address map B for the processor core, a PCI memory device (host mode), a PCI memory device (agent mode), and a PCI I/O device, respectively. When configured for map B, the MPC8245 translates addresses across the internal peripheral logic bus and the external PCI bus, according to Table 3-1 through Table 3-3.

Table 3-1. Address Map B—Processor View in Host Mode

Processor Core Address Range				PCI Address Range	Definition
Hex		Decimal			
0000_0000	6FFF_FFFF	0	2G - 256M - 1	No PCI cycle	Local memory space[1]
7000_0000	7FFF_FFFF	2G - 256M	2G - 1	No PCI cycle	Extended ROM/Flash (256 Mbytes)[11]
8000_0000	FDFF_FFFF	2G	4G - 32M - 1	8000_0000–FDFF_FFFF	PCI memory space[2]
FE00_0000	FE00_FFFF	4G - 32M	4G - 32M + 64K - 1	0000_0000–0000_FFFF	PCI I/O space (8 Mbytes), 0-based[3]
FE01_0000	FE7F_FFFF	4G - 32M + 64K	4G - 24M - 1	Reserved[3]	Reserved[3]
FE80_0000	FEBF_FFFF	4G - 24M	4G - 20M - 1	0080_0000–00BF_FFFF	PCI I/O space (4 Mbytes), 0-based[4]
FEC0_0000	FEDF_FFFF	4G - 20M	4G - 18M - 1	CONFIG_ADDR	PCI configuration address register[5, 12]
FEE0_0000	FEEF_FFFF	4G - 18M	4G - 17M - 1	CONFIG_DATA	PCI configuration data register[6, 12]
FEF0_0000	FEFF_FFFF	4G - 17M	4G - 16M - 1	Interrupt acknowledge broadcast	PCI interrupt acknowledge
FF00_0000	FF7F_FFFF	4G - 16M	4G - 8M - 1	If ROM remote, then range FF00_0000–FF7F_FFFF; if ROM local, then no PCI cycle	8-, 32- or 64-bit Flash/ROM space (8 Mbytes)[7]
FF80_0000	FFFF_FFFF	4G - 8M	4G - 1	If ROM remote, then range FF80_0000–FFFF_FFFF; if ROM local, then no PCI cycle	8-, 32- or 64-bit Flash/ROM space (8 Mbytes)[8]

Table 3-2. Address Map B—PCI Memory Master View in Host Mode

PCI Memory Transaction Address Range				Local Memory Address Range	Definition
Hex		Decimal			
0000_0000	6FFF_FFFF	0	2G - 256M - 1	0000_0000–6FFF_FFFF	Local memory space[1]
7000_0000	7FFF_FFFF	2G - 256M	2G - 1	7000_0000–7FFF_FFFF	Extended ROM/Flash (256 Mbytes)[11]
8000_0000	FEFF_FFFF	2G	4G - 16M - 1	No local memory cycle	PCI memory space[9, 10]
FF00_0000	FF7F_FFFF	4G - 16M	4G - 8M - 1	If ROM local, then FF00_0000–FF7F_FFFF; if ROM remote, then no local memory cycle	8-, 32- or 64-bit Flash/ROM space (8 Mbytes).
FF80_0000	FFFF_FFFF	4G - 8M	4G - 1	If ROM local, then FF80_0000–FFFF_FFFF; if ROM remote, then no local memory cycle	8-, 32- or 64-bit Flash/ROM space (8 Mbytes).

Table 3-3. Address Map B—PCI Memory Master View in Agent Mode

PCI Memory Transaction Address Range	Processor Core Address Range	Definition
(PCSRBAR) – (PCSRBAR + 4 Kbytes)	—	PCI control and status registers
(LMBAR0) – (LMBAR0 + window 0 size)	—	Local memory space 0 as defined by the address translation unit (ATU). See Section 3.3, “Address Translation,” for more information.
(LMBAR1) – (LMBAR1 + window 1 size)	—	Local memory space 1 as defined by the address translation unit (ATU). See Section 3.3, “Address Translation,” for more information.

Table 3-4. Address Map B—PCI I/O Master View

PCI I/O Transaction Address Range				Processor Core Address Range	Definition
Hex		Decimal			
0000_0000	0000_FFFF	0	64K - 1	No system memory cycle	Addressable
0001_0000	007F_FFFF	64K	8M - 1	No system memory cycle	Reserved[3]
0080_0000	00BF_FFFF	8M	12M - 1	No system memory cycle	Addressable
00C0_0000	FFFF_FFFF	12M	4G - 1	No system memory cycle	Not addressable by the processor

Notes

1. Part of address range is separately programmable (see Table 4-45) for the processor interface and the PCI interface to control whether accesses to this address range go to local memory or PCI memory.
2. If AMBOR[CPU_FD_ALIAS_EN] = 1 (see Table 4-45), the MPC8245 forwards processor transactions in the range FD00_0000–FDFF_FFFF to the zero-based PCI memory space with the 8 most significant bits cleared (that is, AD[31:0] = 0x00 || A[8:31] of the internal peripheral logic address bus).
3. Processor addresses are translated to PCI addresses as follows:
   PCI address AD[31:0] = 0x00 || A[8:31] to generate the address range 0000_0000–007F_FFFF. Note that these accesses always miss the outbound translation window. Also note that only 64 Kbytes has been defined (0xFE00_0000–0xFE00–FFFF). The processor address range 0xFE01_0000–0xFE7F_FFFF and the PCI I/O address range 0x0001_0000–0x007F_FFFF is reserved for future use.
4. The MPC8245 forwards processor transactions in this range to the PCI I/O space with the 8 most significant bits cleared (that is, AD[31:0] = 0x00 || A[8:31]). Note that these accesses always miss the outbound translation window.
5. Each word in this address range is aliased to the PCI CONFIG_ADDR register. See Section 4.1, “Configuration Register Access.”
6. Each word in this address range is aliased to the PCI CONFIG_DATA register. See Section 4.1, “Configuration Register Access.”
7. The processor and PCI masters can access ROM/Flash on the local bus in the address range 0xFF00_0000–0xFF7F_FFFF if the ROM/Flash is configured to be on the local bus at reset, see Section 2.4, “Configuration Signals Sampled at Reset.” If PIRC2[CF_FF0_LOCAL] = 1, see Section 4.7, “Processor Interface Configuration Registers”; otherwise, the address is sent to PCI. This address range is always treated as an access to an 8-, 32-, or 64-bit device as configured at reset if it is configured to be on the local bus.
8. The processor and PCI masters can access ROM/Flash on the local bus in the address range 0xFF70_0000–0xFFFF_FFFF if the ROM/Flash is configured to be on the local bus at reset (see Section 2.4, “Configuration Signals Sampled at Reset”); otherwise, the address is sent to PCI. This address range is treated as an access to an 8-, 32-, or 64-bit device as configured at reset if it is configured to be on the local bus.
9. If AMBOR[PCI_FD_ALIAS_EN] = 1 (see Table 4-45), the MPC8245 forwards PCI memory transactions in the range FD00_0000–FDFF_FFFF to local memory with the 8 most significant bits cleared (that is, 0x00 || AD[23:0]).

10. The MPC8245 responds to PCI memory cycles in the range PCSRBAR to PCSRBAR + 4 Kbytes (for run-time registers). PCSRBAR can be programmed to be anywhere from 0x8000_0000 – 0xFCFF_FFFF or from 0xFE00_0000 – 0xFEFF_FFFF.
11. If extended ROM is not enabled (MCCR4[EXTROM] = 0), these addresses can be used for local memory addressing.
12. These address regions appear as a hole in agent mode (and always miss the outbound translation window).

Figure 3-1, Figure 3-2, and Figure 3-3 provide graphical representations of the preceding tables.

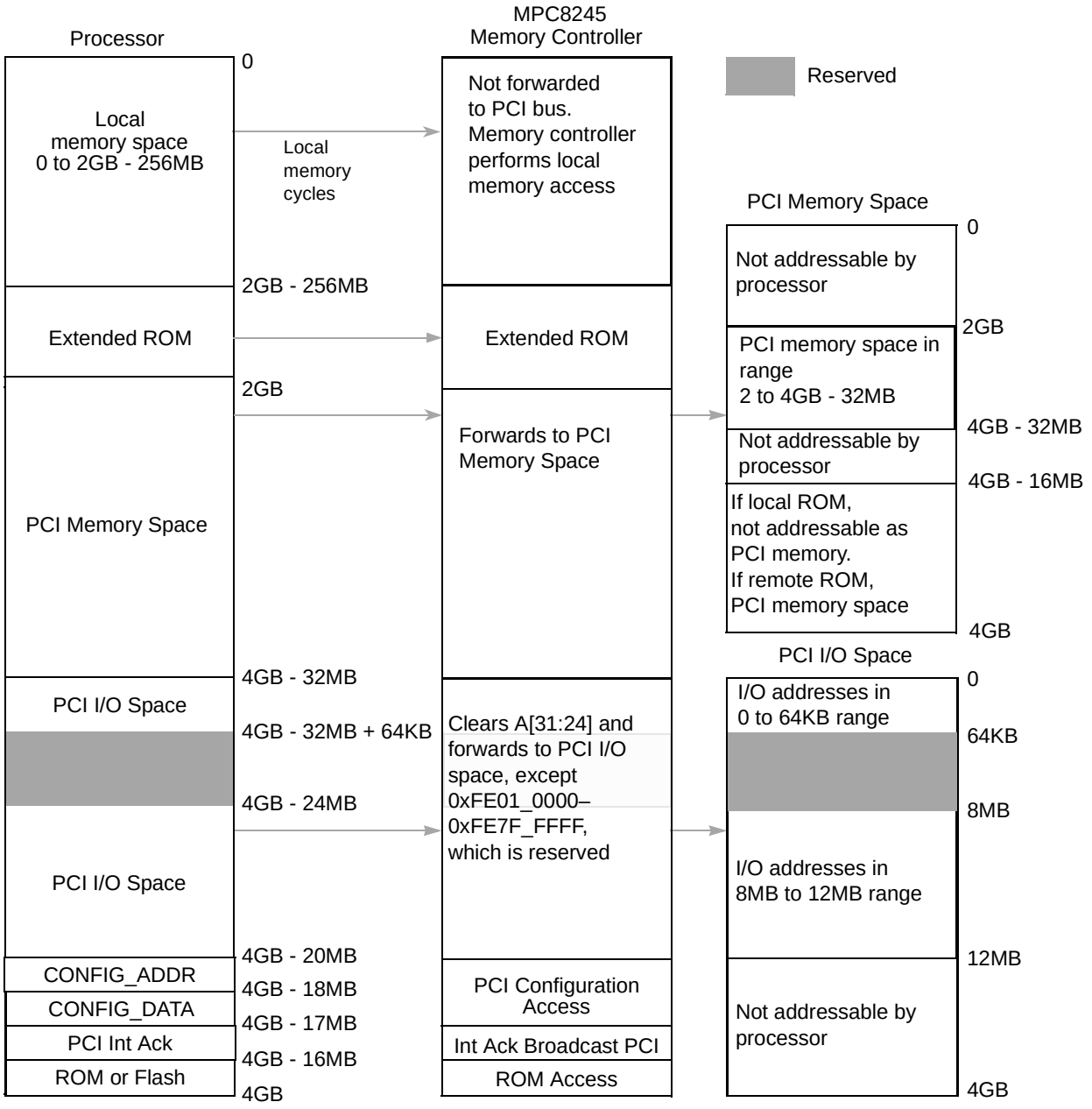


Figure 3-1. Processor Address Map B in Host Mode

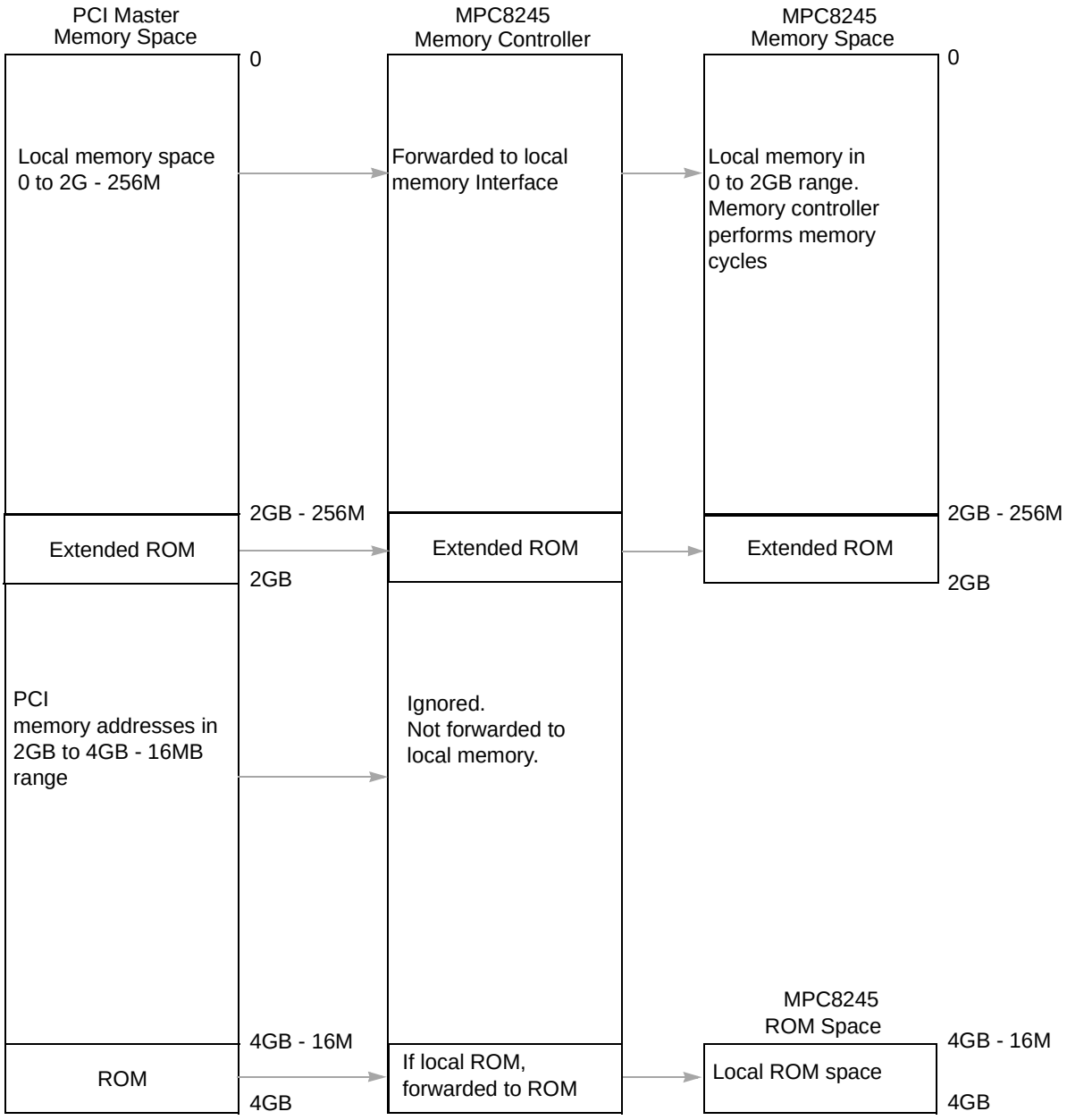


Figure 3-2. PCI Memory Master Address Map B in Host Mode

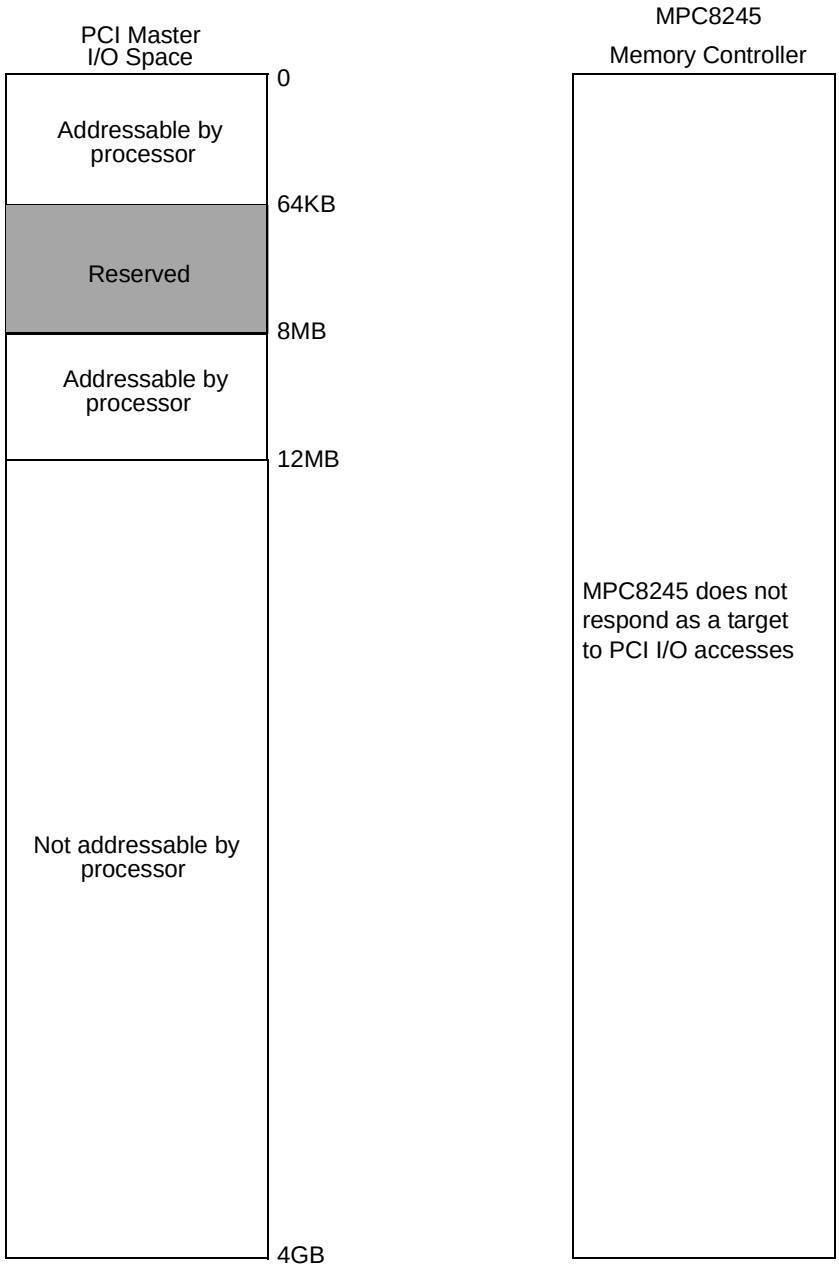


Figure 3-3. PCI I/O Master Address Map B

3.2 Address Map B Options

When configured for address map B and host mode, the MPC8245 supports four optional address mappings that are selectable by programming the AMBOR register (see Table 4-45). The available options are explained in the following sections.

3.2.1 Processor Compatibility Hole

The processor compatibility hole optional mapping can create a hole in the local memory space from 640 Kbytes to 768 Kbytes - 1. Processor core accesses to this range are forwarded untranslated to PCI memory space. The processor compatibility hole is provided for software compatibility with existing PC systems that may use the PCI memory space region from 640 Kbytes to 768 Kbytes - 1 for drivers, firmware, or buffers. Setting the PROC_COMPATIBILITY_HOLE bit in the address map B options register (AMBOR) enables the processor compatibility hole.

3.2.2 PCI Compatibility Hole

The PCI compatibility hole optional mapping can create a hole in the local memory area of PCI memory space from 640 Kbytes to 768 Kbytes - 1. PCI accesses to this range are not claimed by the MPC8245. Thus, this range is available to PCI peripherals (such as video controllers) that require it. The PCI compatibility hole is provided for software compatibility with existing PC systems that may use the PCI memory space region from 640 Kbytes to 768 Kbytes - 1 for drivers, firmware, or buffers. Setting AMBOR[PCI_COMPATIBILITY_HOLE] enables the PCI compatibility hole.

3.2.3 Processor Alias Space

The processor alias space optional mapping can translate processor accesses in the 16-Mbyte range, starting at 0xFD00_0000 to the first 16 Mbytes of PCI memory space. The processor alias space can access devices that cannot be located above 16 Mbytes in PCI memory space (for example, ISA-compatible devices). Setting AMBOR[CPU_FD_ALIAS_EN] enables the processor alias space.

3.2.4 PCI Alias Space

The PCI alias space optional mapping can translate PCI memory space accesses in the 16-Mbyte range, starting at 0xFD00_0000 to the first 16 Mbytes of local memory. Software may use the PCI alias space to access local memory in the 640 Kbyte to 1 Mbyte range when the PCI compatibility hole is enabled. Setting AMBOR[PCI_FD_ALIAS_EN] enables the PCI alias space.

3.2.5 Processor Compatibility Hole and Alias Space

Table 3-5 defines the optional processor compatibility hole and processor alias space and how they fit into map B.

Table 3-5. Address Map B—Processor View in Host Mode Options

Processor Core Address Range				PCI Address Range	Definition
Hex		Decimal			
0000_0000	0009_FFFF	0	640K - 1	No PCI cycle	Local memory space
000A_0000	000F_FFFF	640K	768K - 1	000A_0000–000F_FFFF	Compatibility hole[1]
0010_0000	6FFF_FFFF	768K	2G - 256M - 1	No PCI cycle	Local memory space
7000_0000	7FFF_FFFF	2G - 256M	2G - 1	No PCI cycle	Extended ROM space
8000_0000	FCFF_FFFF	2G	4G - 48M - 1	8000_0000–FCFF_FFFF	PCI memory space
FD00_0000	FDFF_FFFF	4G - 48M	4G - 32M - 1	0000_0000–00FF_FFFF	PCI memory space (16 Mbytes), 0-based[2]
FE00_0000	FE7F_FFFF	4G - 32M	4G - 32M + 64K - 1	0000_0000–0000_FFFF	PCI I/O space (8 Mbytes), 0-based[3]

1. This address range is separately programmable (see Table 4-45) for the processor interface and the PCI interface to control whether accesses to this address range go to local memory or PCI memory.
2. If AMBOR[CPU_FD_ALIAS_EN] = 1 (see Table 4-45), the MPC8245 forwards processor transactions in this range to the zero-based PCI memory space with the 8 most significant bits cleared (that is, AD[31:0] = 0x00 || A[8:31] of the internal peripheral logic address bus).
3. Processor addresses are translated to PCI addresses as follows:
   PCI address (AD[31:0]) = 0x00 || A[8:31] to generate the address range 0000_0000–007F_FFFF. Note that only 64 Kbytes has been defined (0xFE00_0000–0xFE00–FFFF). The processor address range 0xFE01_0000–0xFE7F_FFFF is reserved for future use.

Figure 3-4 shows the optional processor compatibility hole and processor alias space in map B.

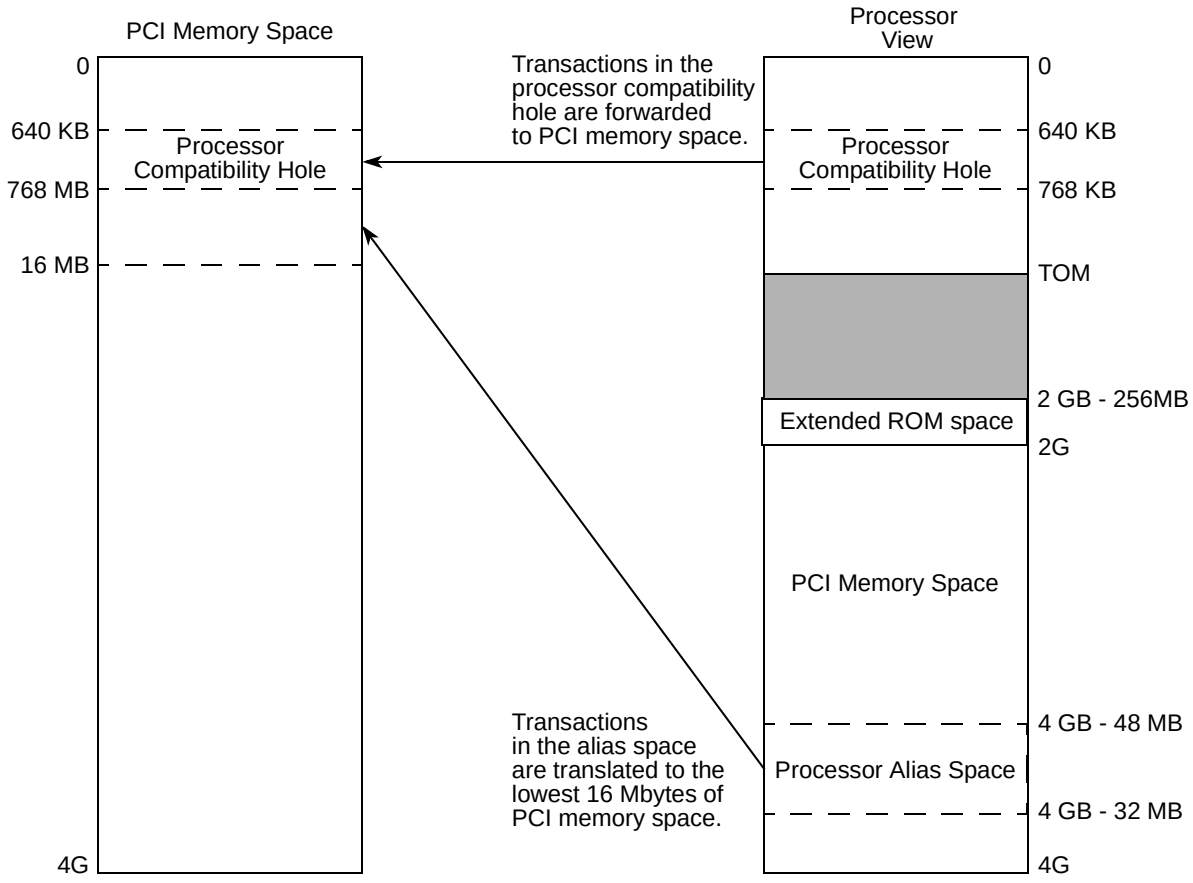


Figure 3-4. Address Map B Processor Options in Host Mode

3.2.6 PCI Compatibility Hole and Alias Space

Table 3-6 defines the optional PCI compatibility hole and PCI alias space and how they fit into map B.

Table 3-6. Address Map B—PCI Memory Master View in Host Mode Options

PCI Memory Transaction Address Range				Local Memory Address Range	Definition
Hex		Decimal			
0000_0000	0009_FFFF	0	640K- 1	0000_0000–0009_FFFF	Local memory space
000A_0000	000F_FFFF	640K	768K - 1	000A_0000–000F_FFFF	Compatibility hole[1]
0010_0000	6FFF_FFFF	768K	2G - 256M - 1	0010_0000–6FFF_FFFF	Local memory space
7000_0000	7FFF_FFFF	2G - 256M	2G - 1	No PCI cycle	Extended ROM space
8000_0000	FCFF_FFFF	2G	4G - 48M - 1	No local memory cycle	PCI memory space[3]
FD00_0000	FDFF_FFFF	4G - 48M	4G - 32M - 1	0000_0000–00FF_FFFF	Local memory space (16 Mbytes), 0-based[2]
FE00_0000	FEFF_FFFF	4G - 32M	4G - 16M - 1	No local memory cycle	Reserved[3]

1. This address range is separately programmable (see Table 4-45) for the processor interface and the PCI interface to control whether accesses to this address range go to local memory or PCI memory.
2. If AMBOR[PCI_FD_ALIAS_EN] = 1 (see Table 4-45), the MPC8245 forwards PCI memory transactions in this range to local memory with the 8 most significant bits cleared (that is, 0x00 || AD[23:0]).
3. The MPC8245 responds to PCI memory cycles in the range PCSRBAR to PCSRBAR + 4 Kbytes (for run-time registers). PCSRBAR can be programmed to be anywhere from 0x8000_0000 – 0xFCFF_FFFF or from 0xFE00_0000 – 0xFEFF_FFFF.

Figure 3-5 shows the optional PCI compatibility hole and PCI alias space in map B.

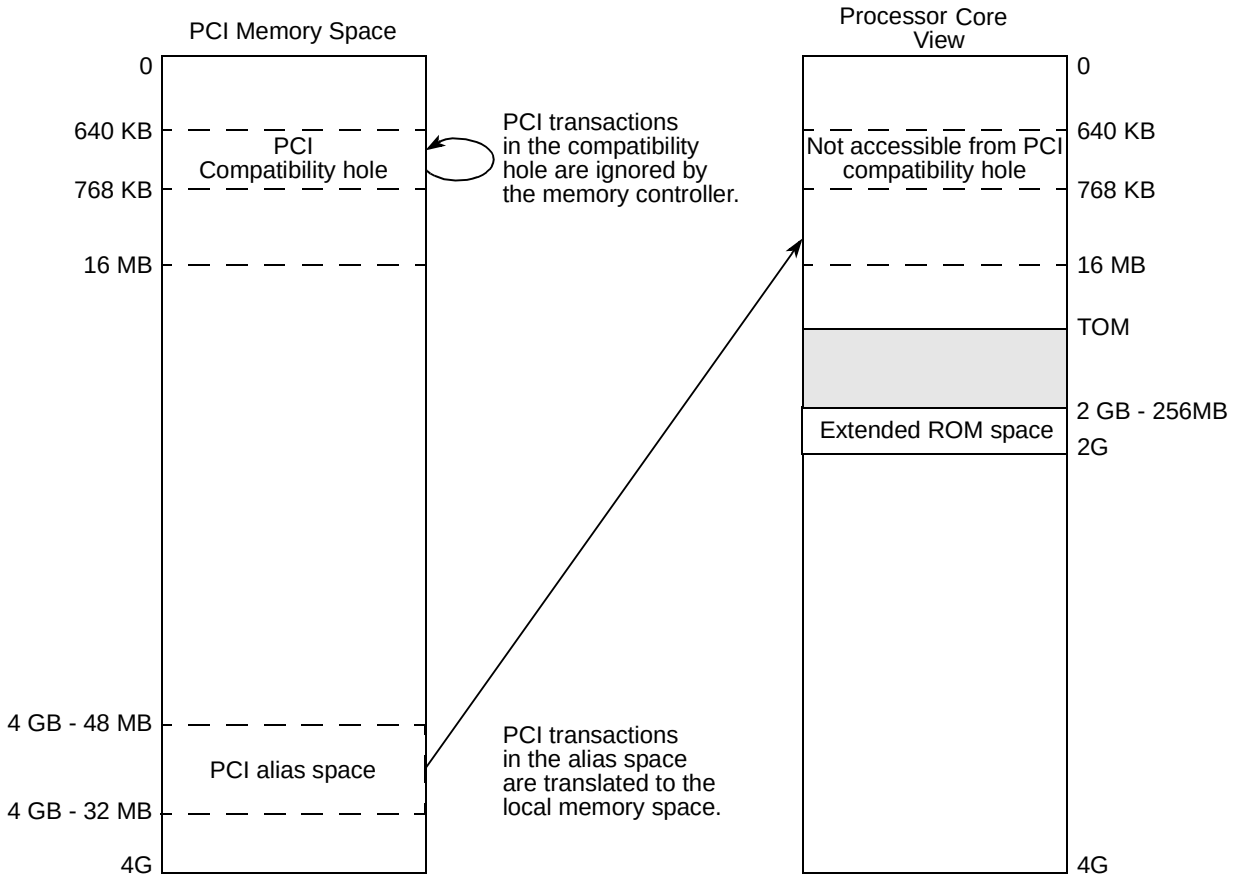


Figure 3-5. Address Map B PCI Options in Host Mode

3.3 Address Translation

The MPC8245 allows remapping of PCI to local memory (inbound) transactions and processor core to PCI (outbound) transactions. Agent mode supports both inbound and outbound translation. Host mode supports only outbound translation. The following sections describe the address translation support of the MPC8245.

The MPC8245 has two outbound translation windows and two inbound translation windows. Both outbound translation windows are capable of generating translated dual address cycles (DACs) or translated single address cycles (SACs) to the PCI bus. Both inbound windows receive only SAC transactions from the PCI bus.

All the configuration registers of the MPC8245 are intrinsically little-endian. In the register descriptions of this chapter, bit 0 is the least significant bit of the register. This bit numbering is based on the PCI standard for register bit order numbering and is opposite from big endian bit ordering in the PowerPC architecture. For big endian bit ordering, bit 0 is the most significant bit of the register.

3.3.1 Inbound PCI Address Translation

For inbound address translation, two inbound memory windows are specified in PCI memory space and two inbound translation windows are specified in the MPC8245 local memory space. PCI memory accesses in either of the inbound memory windows are claimed by the MPC8245 and forwarded to local memory with the address translated to the corresponding inbound translation window. PCI memory transactions outside of both inbound memory windows are ignored (not claimed) by the MPC8245 unless they fall within the embedded utilities memory block (EUMB). PCI memory accesses that fall within the EUMB are handled as described in Section 3.4, “Embedded Utilities Memory Block (EUMB),” regardless of address translation. The translated address should not fall between two Gbytes to four Gbytes.

Figure 3-6 shows inbound PCI address translation from PCI memory space to the local memory space.

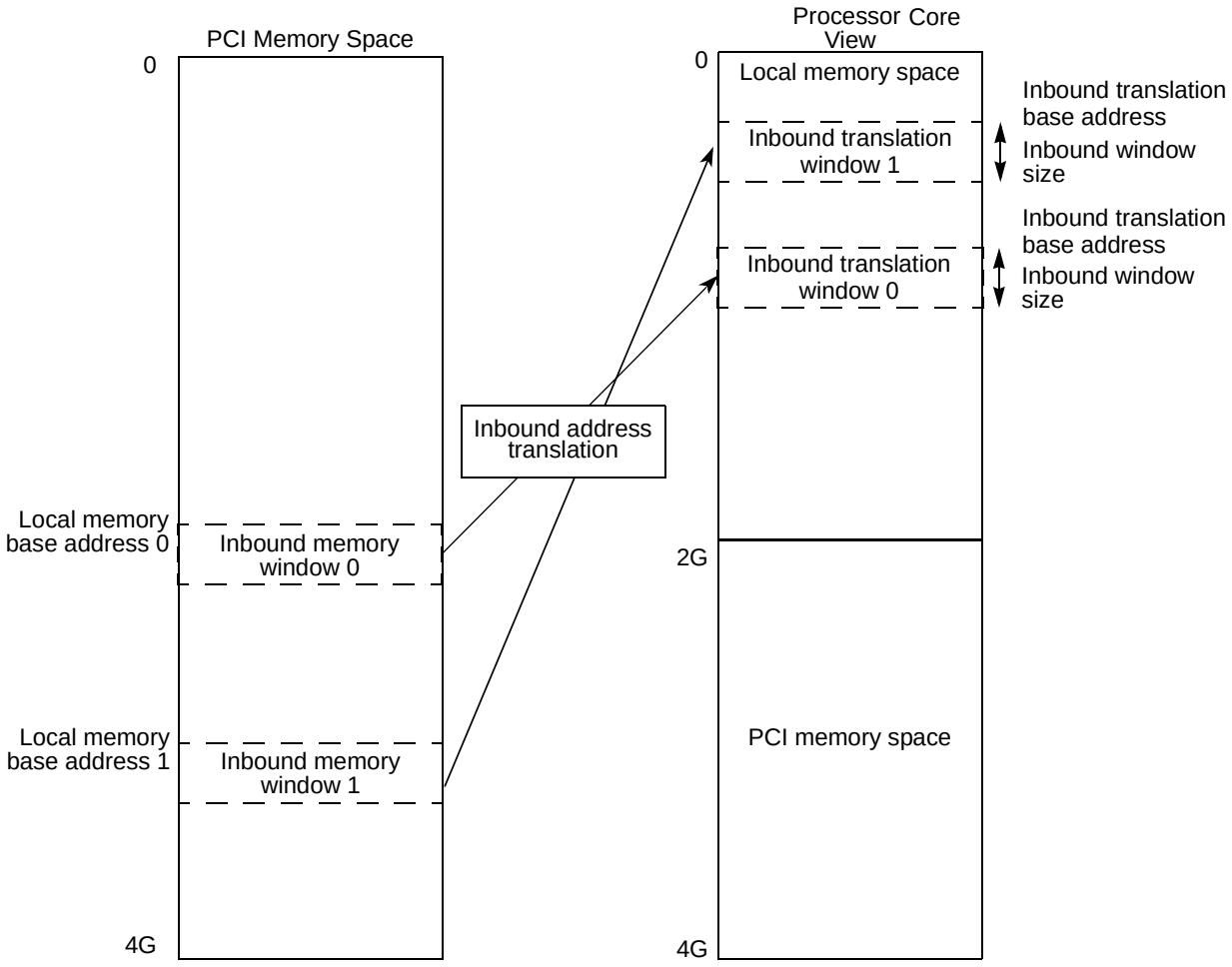


Figure 3-6. Inbound PCI Address Translation

The local memory base address registers (LMBAR0 and LMBAR1) and the inbound translation window registers (ITWR0 and ITWR1) specify the location and size of the inbound memory windows and the inbound translation windows, respectively. These registers are described in Section 3.3.4, “Address Translation Registers.” To disable inbound address translation, program the inbound window size in both ITWRs to all zeros. If inbound translation is disabled, the MPC8245 ignores all PCI memory transactions except transactions to EUMB area.

Take care in system operation with multiple address translation windows. For translation purposes, many-to-one mapping is supported, but one-to-many mapping is not supported. In many-to-one mapping, shown in Figure 3-7, two inbound source addresses may be

different, but the translation destination on the local memory can be the same or overlapped. This factor can be used for shared memory systems.

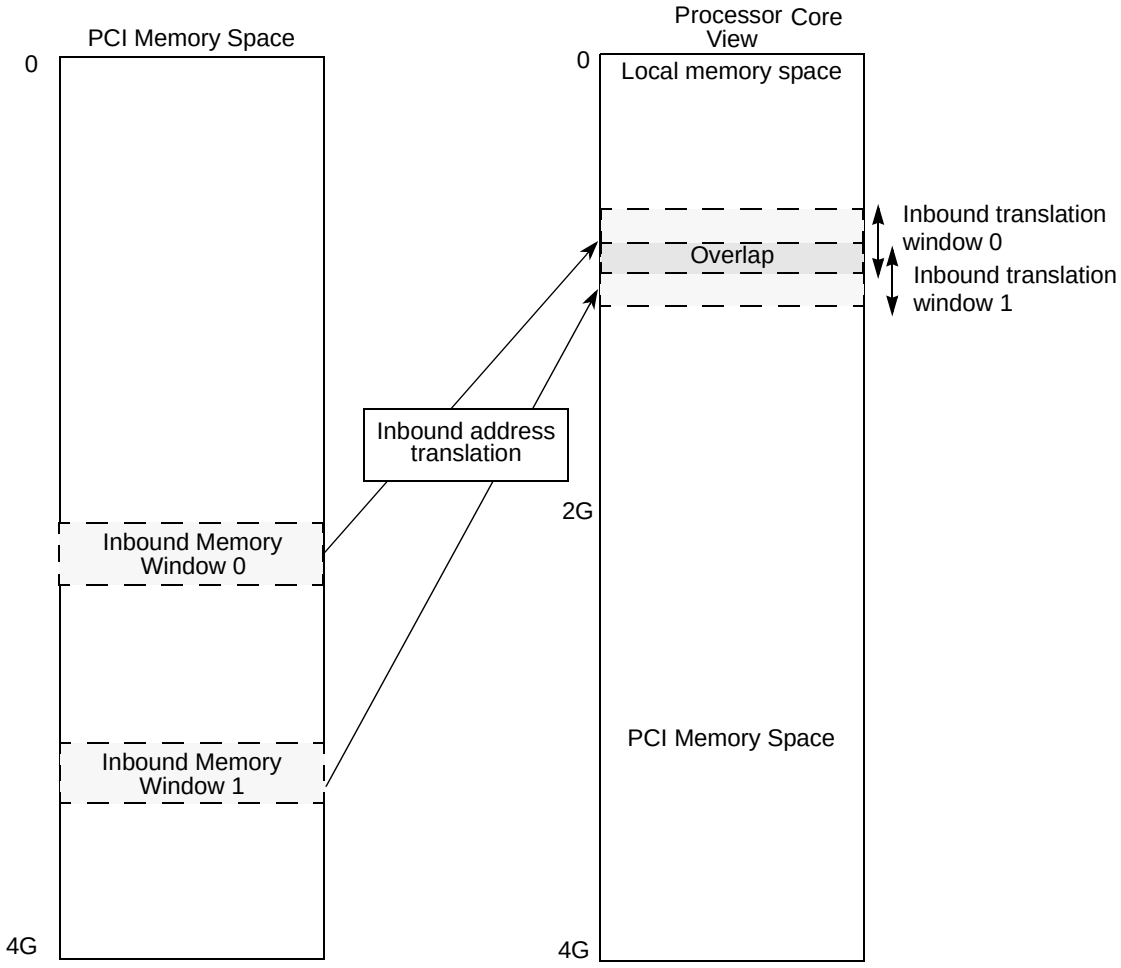


Figure 3-7. Many-to-One Mapping

In one-to-many mapping, shown in Figure 3-8, the source addresses are the same or overlap, but the destination addresses are different. In this case, the MPC8245 cannot determine the intended destination.

NOTE

One-to-many mapping is a programming error.

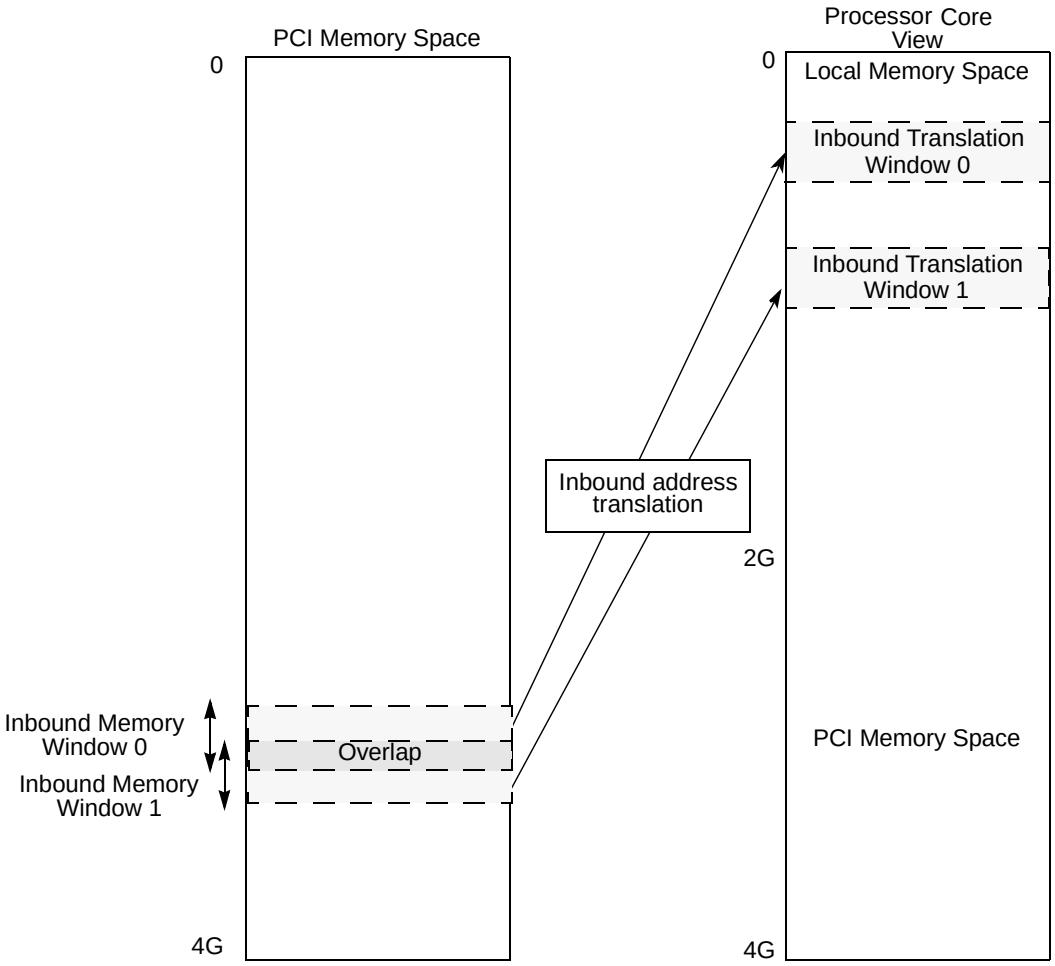


Figure 3-8. One-to-Many Mapping

NOTE

Overlapping an inbound memory window with an outbound translation window is not supported and can cause unpredictable behavior, and that the inbound memory window must not overlap the EUMB, effectively one-to-many mapping, as specified by the PCSRBAR (PCI memory space view). See Section 3.4, “Embedded Utilities Memory Block (EUMB),” for more information.

3.3.2 Outbound PCI Address Translation

Outbound memory translation can be enabled in either host or agent mode. Note that outbound translation in host mode mainly supports 64-bit addressable PCI devices by using DAC. For outbound translation, two outbound memory windows are specified in the upper two Gbytes of the MPC8245 address space, and two outbound translation windows are specified in the PCI memory space. Processor and DMA transactions that fall within either of outbound memory windows are forwarded to the PCI bus with the address translated to the corresponding outbound translation window. Outbound transaction addresses outside of either outbound memory window are forwarded to the PCI bus untranslated. When the MPC8245 is configured in PCI agent mode, outbound memory translation is required to allow master access to host memory space.

Figure 3-9 shows outbound PCI address translation from the processor core address space to PCI memory space.

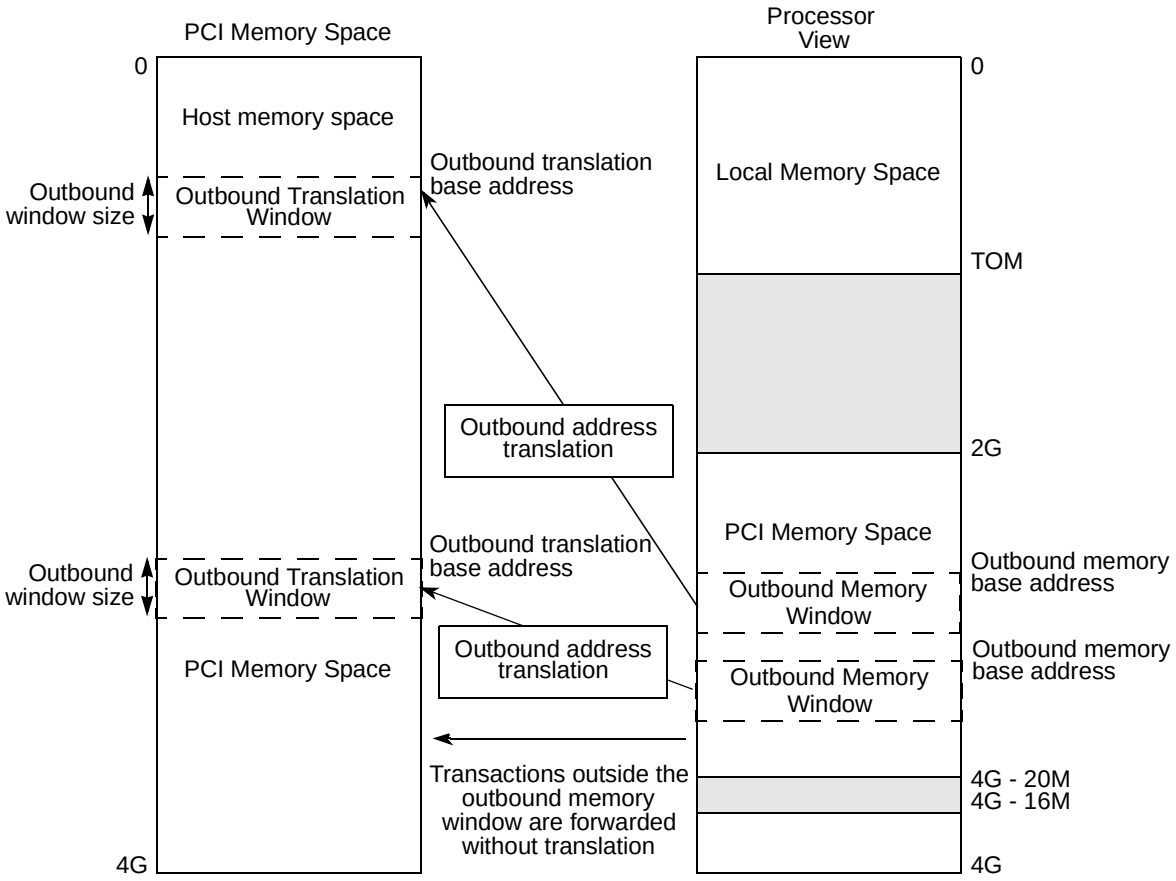


Figure 3-9. Outbound PCI Address Translation, OTHBAR = 0

Transactions to the MPC8245 address space marked as configuration address, configuration data, and interrupt acknowledge (0xFEC0_0000–0xFEFF_FFFF) are excluded from the outbound memory window. If an outbound memory base address is set

to include this range, the MPC8245 does not translate the accesses to the outbound translation window. That is, the range appears as a hole in the outbound translation.

The outbound memory base address registers (OMBAR0 and OMBAR1) and the outbound translation window registers (OTWR0 and OTWR1) specify the location and size of the outbound memory windows and the outbound translation windows, respectively. These registers are described in Section 3.3.4, “Address Translation Registers.” Program the outbound window size to all zeros to disable outbound address translation.

NOTE

Overlapping an inbound memory window and an outbound translation window is not supported and can cause unpredictable behavior. This “mapping loop” is a programming error. Also, an outbound memory window and its corresponding outbound translation window must not overlap with the EUMB, effectively one-to-many mapping, as specified by the EUMBBAR (from the processor’s view) or the PCSRBAR (from the PCI memory space view). Operation is not guaranteed if the two are overlapping. However, the two outbound translation windows can be overlapped, effectively many-to-one mapping (which is useful in some shared memory architectures).

For outbound SAC transactions to the PCI bus, both local processor and DMA addresses that hit the outbound translation window are issued on the PCI bus as SAC transactions with a translated address.

NOTE

Software can adjust the sizes and location of the outbound translation windows during run-time.

3.3.3 Outbound PCI Address Translation Using Dual Address Cycles

DAC cycles can also be performed on the PCI bus. If the OTHBAR*n* registers are programmed with non-zero values and a transaction from the processor core hits in one of the outbound windows, a DAC transaction is generated on the PCI bus with the translated lower 32-bit addresses. If the transaction misses the outbound windows, a SAC transaction is generated.

NOTE

OTHBAR*n* only applies for processor to PCI accesses and not DMA. See Section 3.3.4.3, “Outbound Translation High Base Address Registers (OTHBARn).”

For a DMA transaction, if the corresponding high order address register is nonzero, a DAC transaction is generated whether or not the transaction hits in the outbound windows. The lower 32-bit address of the DMA DAC transaction is not translated. See Section 8.3, “DMA Operation,” for more information.

Figure 3-10 shows outbound PCI address translation from the processor core address space to PCI memory space using DACs.

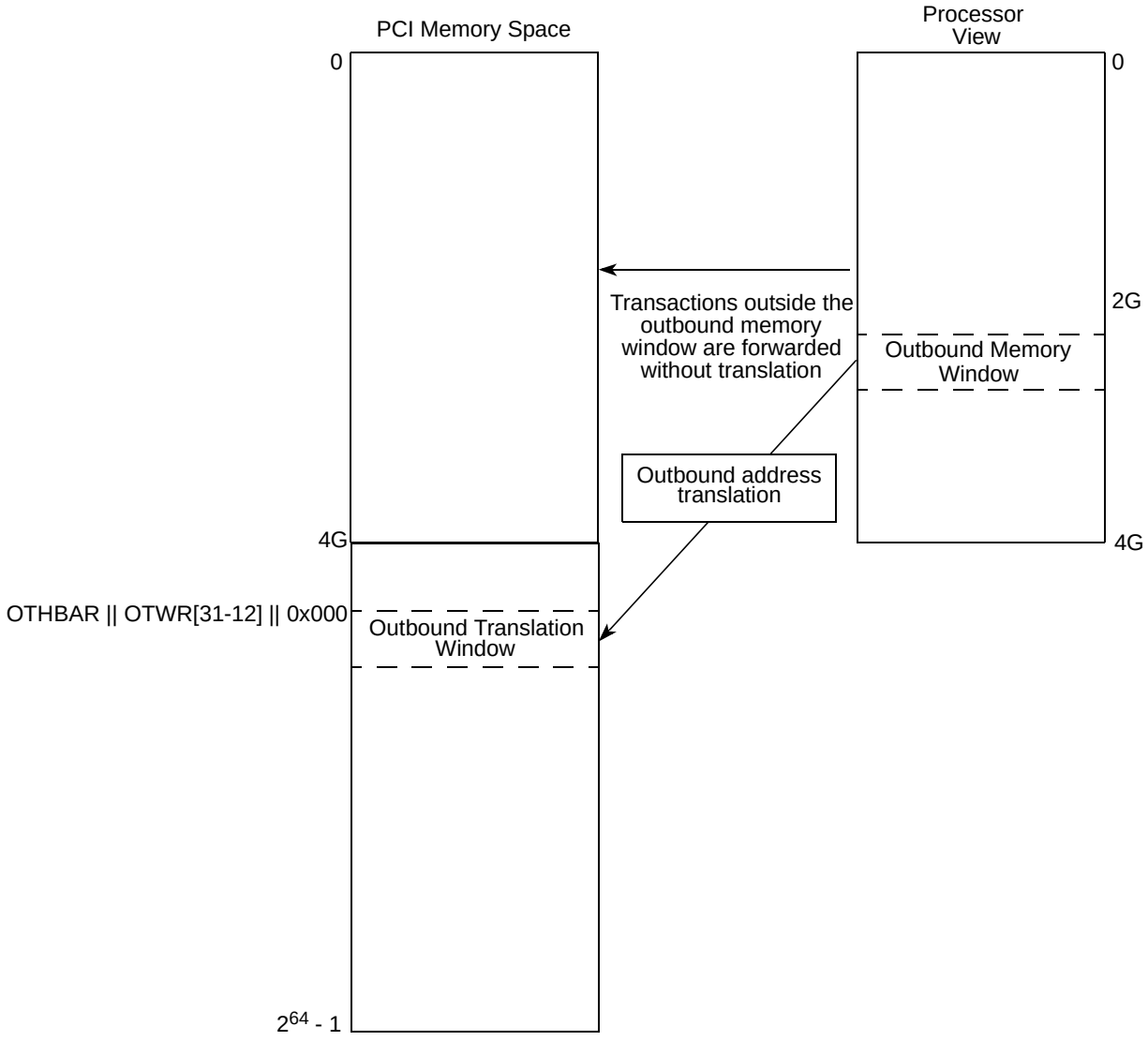


Figure 3-10. Outbound Dual Address Cycles, OTHBAR ≠ 0

3.3.4 Address Translation Registers

This section describes the address translation registers in detail. The address translation registers, summarized in Table 3-7 in register offset order, specify the windows for inbound and outbound address translation. The detailed register descriptions in the rest of this section are ordered as inbound registers (LMBAR*n* and ITWR*n*) followed by outbound registers (OTHBAR*n*, OMBAR*n*, and OTWR*n*).

Table 3-7. ATU Register Summary

Register Name	Location	Description
Local memory base address register 0 (LMBAR0)	MPC8245 internal configuration registers. See Chapter 4, “Configuration Registers” Offset 0x10	Specifies the starting address of the first inbound memory window. PCI memory transactions in this inbound memory window are translated to the first inbound translation window (specified by ITWR0) in local memory.
Local memory base address register 1 (LMBAR1)	MPC8245 internal configuration registers. See Chapter 4, “Configuration Registers” Offset 0x18	Specifies the starting address of the second inbound memory window. PCI memory transactions in this inbound memory window are translated to the second inbound translation window (specified by ITWR1) in local memory.
Outbound memory base address register 0 (OMBAR0)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_2300 (local) Offset 0x300 (PCI)	Specifies the starting address for the first outbound memory window. Processor transactions in this outbound memory window are translated to the first outbound translation window (specified by OTWR0) in PCI memory space.
Outbound translation window register 0 (OTWR0)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_2308 (local) Offset 0x308 (PCI)	Specifies the starting address of the first outbound translation window and the size of the window.
Outbound translation high base address register 0 (OTHBAR0)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_230C (local) Offset 0x30C (PCI)	Specifies the 64-bit starting address of the region in memory for the first outbound memory window. DAC cycles are generated if this register is nonzero. SAC cycles are generated if the register is cleared to zero. This register only applies to processor accesses to PCI.
Inbound translation window register 0 (ITWR0)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_2310 (local) Offset 0x310 (PCI)	Specifies the starting address of the first inbound translation window and the size of the window.
Outbound memory base address register 1 (OMBAR1)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_2320 (local) Offset 0x320 (PCI)	Specifies the starting address for the second outbound memory window. Processor transactions in this outbound memory window are translated to the second outbound translation window (specified by OTWR1) in PCI memory space.
Outbound translation window register 1 (OTWR1)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_2328 (local) Offset 0x328 (PCI)	Specifies the starting address of the second outbound translation window and the size of the window.

Table 3-7. ATU Register Summary (continued)

Register Name	Location	Description
Outbound translation high base address register 1 (OTHBAR1)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_232C (local) Offset 0x32C (PCI)	Specifies the 64-bit starting address of the region in memory for the second outbound memory window. DAC cycles are generated if this register is nonzero. SAC cycles are generated if the register is cleared to zero. This register only applies to processor access to PCI.
Inbound translation window register 1 (ITWR1)	EUMB. See Section 3.4, “Embedded Utilities Memory Block (EUMB)” Offset 0x0_2330 (local) Offset 0x330 (PCI)	Specifies the starting address of the second inbound translation window and the size of the window.

3.3.4.1 Local Memory Base Address Registers (LMBAR*n*)

The LMBAR*n*, shown in Figure 3-11 and Table 3-8, define the two inbound memory windows. LMBAR0 at offset 0x10 defines the first window and LMBAR1 at offset 0x18 defines the second window. Note that if the base address is not naturally aligned with respect to the programmed translation window size in ITWR*n*, those low-order address bits do not reconstruct the translated address. Instead, those address bits come from the PCI address as part of the offset.

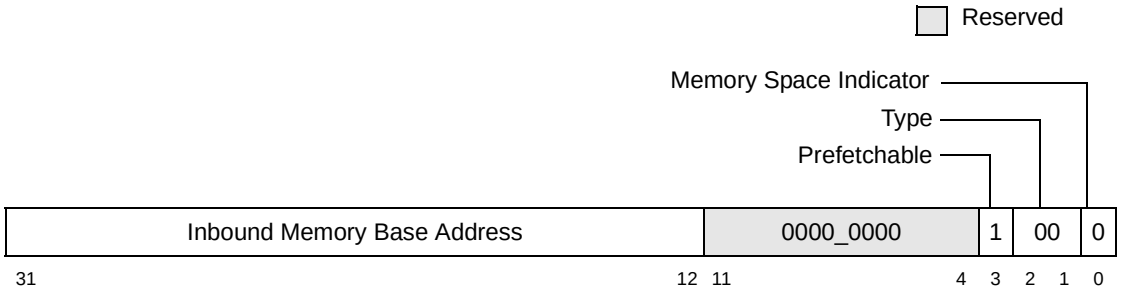


Figure 3-11. Local Memory Base Address Registers (LMBAR*n*)—Offset 0x10 and 0x18

Table 3-8. Bit Settings for LMBAR*n*—0x10 and 0x18

Bits	Name	Reset Value	R/W	Description
31–12	Inbound memory base address	0x0000_0	R/W	Indicates the base address where the corresponding inbound memory window resides. The inbound memory window should be aligned based on the granularity specified by the inbound window size specified in the ITWR*n*. Note that the EUMB area must be selected first. Then the ITWR*n* is programmed, and subsequently these bits can be set.
11–4	—	All 0s	R	Reserved; the MPC8245 allows only a minimum of a 4 KByte window.
3	Prefetchable	1	R	Indicates that the space is prefetchable.

Table 3-8. Bit Settings for LMBAR*n*—0x10 and 0x18 (continued)

Bits	Name	Reset Value	R/W	Description
2–1	Type	00	R	The inbound memory window may be located anywhere within the 32-bit PCI address space.
0	Memory space indicator	0	R	Indicates PCI memory space.

3.3.4.2 Inbound Translation Window Registers (ITWR*n*)

The ITWR*n* registers, shown in Figure 3-12 and Table 3-9, define the two inbound translation windows and the inbound window sizes. ITWR0 at offset 0x0_2310 defines the first window and ITWR1 at offset 0x0_2330 defines the second window. The inbound window size in the ITWR*n* sets the size of both the corresponding inbound translation window in local memory and the inbound memory window in PCI memory space. Software can alter the inbound translation base address in the ITWR*n* during run-time to access different portions of local memory. Because the inbound memory base address in the LMBAR*n* should be aligned to the inbound window size in the ITWR*n*, the inbound window size should not be changed without also updating the LMBAR*n*. As a general rule, the ITWRn should be programmed before first programming the LMBAR*n*.

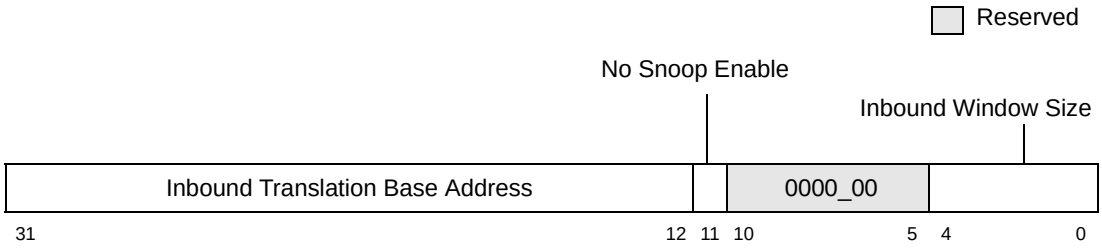


Figure 3-12. Inbound Translation Window Register (ITWR*n*)—Offset 0x0_2310 and 0x0_2330

Table 3-9. Bit Settings for ITWR*n*—0x0_2310 and 0x0_2330

Bits	Name	Reset Value	R/W	Description
31–12	Inbound translation base address	Undefined	R/W	Local memory address that is the starting address for the inbound translation window, which should be aligned based on the granularity specified by the inbound window size. Software should program the base address to target only the lower two Gbytes of space.
11	No snoop enable	0	R/W	Disables snooping on the peripheral logic bus for PCI transactions to local memory that hit the inbound translation window. By default, snooping on the peripheral logic bus is allowed. Note this bit is only valid in agent mode. In host mode, snooping is always allowed. Whether snoop cycles actually occur further depends on the setting of the NO_SNOOP_EN bit in PICR2. PICR2[NO_SNOOP_ENABLE] is the master enable that controls snooping for on the peripheral logic bus for any PCI or DMA transaction. ITWR[NO_SNOOP_EN] is the local enable that controls snooping of the inbound translation window. Only PICR2[NO_SNOOP_EN] needs to be set to disable snoop cycles. 0 Snooping is enabled 1 Snooping is disabled
10–5	—	All 0s	R	Reserved
4–0	Inbound window size	All 0s	R/W	Inbound window size. The inbound window size is encoded as N where the window size is 2^{N+1} bytes. The minimum window size is 4 Kbytes; the maximum window size is 1 Gbyte. Note that the inbound window size sets the size of both the inbound memory window and the inbound translation window. 0_0000 Inbound address translation disabled 0_0001 Reserved ... 0_1010 Reserved 0_1011 2^{12} = 4-Kbyte window size 0_1100 2^{13} = 8-Kbyte window size 0_1101 2^{14} = 16-Kbyte window size ... 1_1101 2^{30} = 1-Gbyte window size 1_1110 2^{31} = 2-Gbyte window size 1_1111 Reserved Note that the inbound memory window must not overlap with the EUMB.

The lower-order address bits of the base address field of ITWR*n* that are within the range that the window size specified are ignored, and the MPC8245 ignores the incoming lower-order address bits (within the range specified by the window size). However, to accommodate future compatibility, Motorola recommends programming the base address to be naturally aligned to the window size. For example, if the window size is programmed as 1 Mbyte, the base address should be aligned to a 1-Mbyte boundary (as ITWR*n*[19–12] do not determine if the inbound translation window is affected for a 1-Mbyte window).

3.3.4.3 Outbound Translation High Base Address Registers (OTHBAR*n*)

The OTHBAR*n* registers, shown in Figure 3-13 and Table 3-10, define the upper 32 bits of address for outbound DAC cycles (used in 64-bit PCI addressing) for the two outbound memory windows. OTHBAR0 at offset 0x0_230C defines the high base address for the first outbound memory window, and OTHBAR1 at offset 0x0_232C defines the high base address for the second outbound memory window.

NOTE

OTHBARn registers apply only to processor-to-PCI accesses and are irrelevant for DMA to PCI accesses.

If DMA issues a 32-bit transfer to PCI and the transfer hits an outbound window with OTHBAR nonzero, a translated SAC is performed, rather than a DAC. For DMA DAC transfers, software should program the appropriate high address registers in the DMA as nonzero. In that case, the DMA DAC transfer always misses the outbound windows. See Section 8.3, “DMA Operation,” for more information.

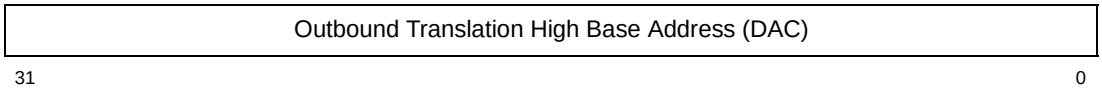


Figure 3-13. Outbound Translation High Base Address Registers (OTHBAR*n*)—Offset 0x0_0230C and 0x0_232C

Table 3-10. Bit Settings for OTHBAR*n*—0x0_0230C and 0x0_232C

Bits	Name	Reset Value	R/W	Description
31–0	Outbound high base address	All 0s	R/W	This field defines the upper 32-bit base address for an outbound translation window generates DAC cycles on the PCI bus for local CPU transactions that are directed to the PCI bus. • A nonzero value enables the DAC functionality. • A value of all zeros disables the DAC functionality and causes only SAC cycles to be generated.

3.3.4.4 Outbound Memory Base Address Registers (OMBAR*n*)

OMBAR*n* registers, shown in Figure 3-14 and Table 3-11, define the outbound memory windows. OMBAR0 at offset 0x0_2300 defines the first outbound memory window and OMBAR1 at offset 0x0_2320 defines the second outbound memory window.

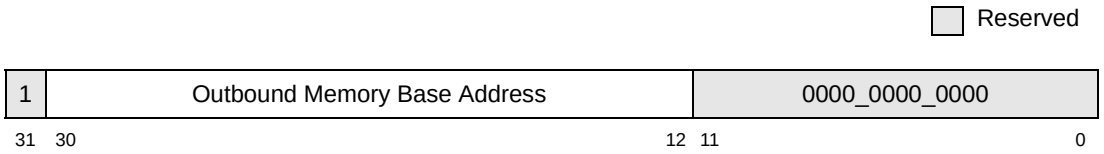


Figure 3-14. Outbound Memory Base Address Registers (OMBAR*n*)—Offset 0x0_2300 and 0x0_2320

Table 3-11. Bit Settings for OMBAR*n*—0x0_2300 and 0x0_2320

Bits	Name	Reset Value	R/W	Description
31	—	1	R	Reserved. The outbound memory window must reside in the upper two Gbytes of the MPC8245 address space.
30–12	Outbound memory base address	Undefined	R/W	Processor address that is the starting address for the outbound memory window. The outbound memory window must be aligned based on the granularity specified by the outbound window size specified in the corresponding OTWR*n*.
11 – 0	—	All 0s	R	Reserved

3.3.4.5 Outbound Translation Window Register (OTWR*n*)

OTWR*n* registers, shown in Figure 3-15 and Table 3-12, define the outbound translation window and outbound window sizes for the two outbound translation windows. OTWR0 defines the first outbound translation window and OTWR1 defines the second outbound translation window. The outbound window size in OTWR*n* sets the size of both the outbound translation window in PCI memory space and the outbound memory window in the processor address space. Software can alter the outbound translation base address and the outbound translation window size during run-time to allow software to scroll through host memory or address alternate space as needed.

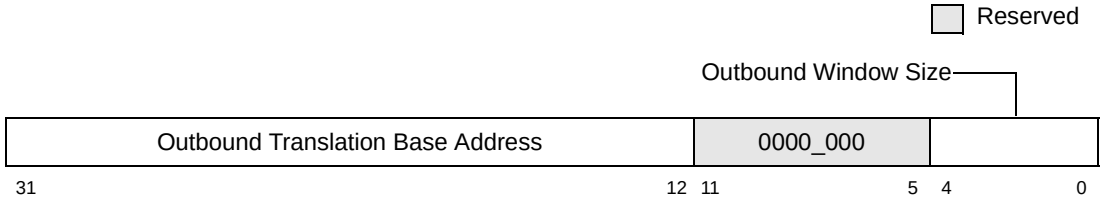


Figure 3-15. Outbound Translation Window Registers (OTWR*n*)—Offset 0x0_2308 and 0x0_2328

Table 3-12. Bit Settings for OTWR*n*—0x0_2308 and 0x0_2328

Bits	Name	Reset Value	R/W	Description
31–12	Outbound translation base address	Undefined	R/W	PCI memory address: the starting address for the outbound translation window. The outbound translation window should be aligned based on the granularity that the outbound window size specifies.
11–5	—	All 0s	R	Reserved
4–0	Outbound window size	All 0s	R/W	Outbound window size. The outbound window size is encoded as N where the window size is 2^{N+1} bytes. The minimum window size is 4 Kbytes; the maximum window size is 1 Gbyte. Note that the outbound window size sets the size of both the outbound memory window and the outbound translation window. 00000 Outbound address translation disabled 00001 Reserved ... 01010 Reserved 01011 2^{12} = 4-Kbyte window size 01100 2^{13} = 8-Kbyte window size 01101 2^{14} = 16-Kbyte window size ... 11101 2^{30} = 1-Gbyte window size 11110 2^{31} = 2-Gbyte window size 11111 Reserved Note that the outbound memory window must not overlap with the EUMB.

The MPC8245 ignores the outgoing lower-order address bits that are within the range that the window size specifies. However, for future compatibility, Motorola recommends that programming the base address to be naturally aligned to the window size.

3.4 Embedded Utilities Memory Block (EUMB)

The MPC8245 contains several embedded features that require control and status registers that are accessible during normal operation. The features include the following:

- DMA controller, message unit
- DUART
- PIC
- I^2C
- ATU
- performance monitor
- memory data path diagnostic logic (including watchpoint facility)

These registers in some cases are accessible by both the processor core and the PCI bus. The collection of these units is called the embedded utilities. These registers comprise the run-time registers, and a block of local memory and PCI memory space is allocated to them.

The embedded utilities memory block (EUMB) is relocatable both in PCI memory space (for PCI access) and local memory space (for processor access). The local memory map location of this register block is controlled by the embedded utilities memory block base address register (EUMBBAR). In the processor's local memory map, the registers that comprise the EUMB (specified by the EUMBBAR) are restricted to locations 0x8000_0000 to 0xFDFF_FFFF (see Section 3.1, "Address Map B"). The PCI bus memory map location for this block is controlled by the peripheral control and status registers base address register (PCSRBAR). In the PCI memory space, the registers of the EUMB (specified by PCSRBAR) may reside in any unused portion of the PCI memory space. See Section 4.2.7, "PCI Base Address Registers—LMBARn and PCSRBAR."

NOTE

The EUMB should not reside inside either the outbound memory window or the outbound translation window. Operation is not guaranteed if the two are overlapping. The processor must not run transactions to the PCI memory space allocated for the EUMB by the PCSRBAR.

All registers in the EUMB except the DUART registers are accessible with 32-bit accesses only. Transactions of sizes other than 32-bit cause a programming error, and, if they are used, operation is not guaranteed. The DUART registers are byte addressable. Additionally, accesses to the EUMB must be strictly ordered. Therefore, the EUMB should be marked caching-inhibited and guarded using the WIMG memory/cache access attributes in the processor's BAT or page table entries. The **eieio** instruction has no effect on the MPC603e and MPC750 families of processors.

3.4.1 Processor Core Control and Status Registers

Figure 3-16 shows the location of the memory mapped registers of the EUMB that are accessible by the processor for the DMA controller, message unit, DUART, PIC, I^2C, ATU, performance monitor, and memory data path diagnostic logic (including watchpoint facility).

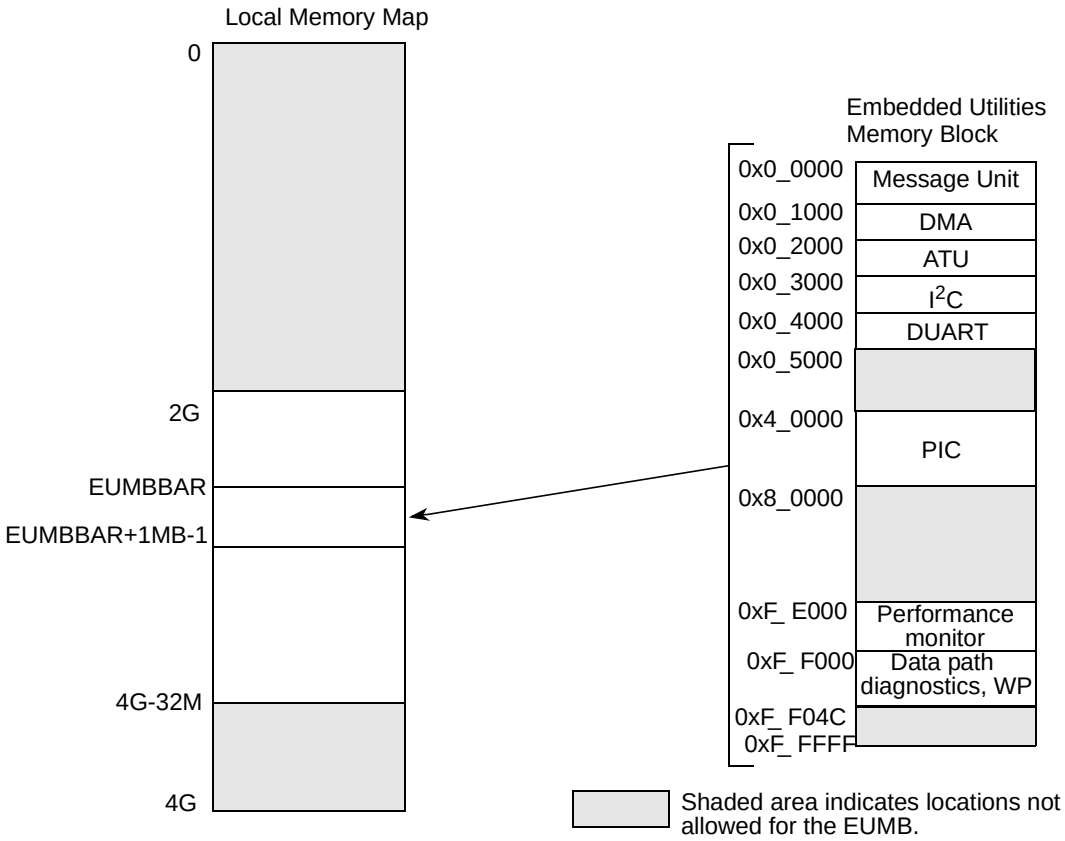


Figure 3-16. Embedded Utilities Memory Block Mapping to Local Memory

Table 3-13 summarizes the embedded utilities' local memory registers and their offsets.

Table 3-13. Embedded Utilities Local Memory Register Summary

Local Memory Offset	Register Set	Reference
0x0_0000 - 0x0_0FFF	Message registers, doorbell interface, I_2O	Section 9.2.1, "Message and Doorbell Register Summary" and Section 9.3.2, "I2O Register Summary"
0x0_1000 – 0x0_1FFF	DMA controller	Section 8.2, "DMA Register Summary"
0x0_2000 – 0x0_2FFF	ATU	Section 3.3.4, "Address Translation Registers"
0x0_3000 – 0x0_3FFF	I^2C controller	Section 10.3, "I2C Register Descriptions"
0x0_4000 – 0x0_4FFF	DUART	Section 12.1.5, "DUART Register Summary"
0x0_5000 – 0x3_FFFF	Reserved	—

Table 3-13. Embedded Utilities Local Memory Register Summary (continued)

Local Memory Offset	Register Set	Reference
0x4_0000 – 0x7_FFFF	PIC controller	Section 11.2, “PIC Register Summary”
0x8_0000 – 0xF_DFFF	Reserved	—
0xF_E000 – 0xF_EFFF	Performance monitor	Section 16.2.3, “Performance Monitor Counter (PMC0–PMC3)”
0xF_F000 – 0xF_F017	Data path diagnostics	Section 17.1, “Debug Register Summary”
0xF_F018 – 0xF_F04B	Data path diagnostics and watchpoint registers	Chapter 18, “Programmable I/O and Watchpoint”
0xF_F04C – 0xF_FFFF	Reserved	—

3.4.2 Peripheral Control and Status Registers

The MPC8245 contains a set of memory mapped registers that are accessible from the PCI bus in both host and agent mode. These registers allow external masters on the PCI bus to access the MPC8245 on-chip embedded utilities such as the message unit, DMA controller, ATU, I^2C, DUART, performance monitor, and memory data path diagnostic logic as shown in Figure 3-17. The region requires four Kbytes of PCI memory space. The base address for this region is selectable through the PCI configuration register PCSRBAR (see Section 4.2.7, “PCI Base Address Registers—LMBARn and PCSRBAR”).

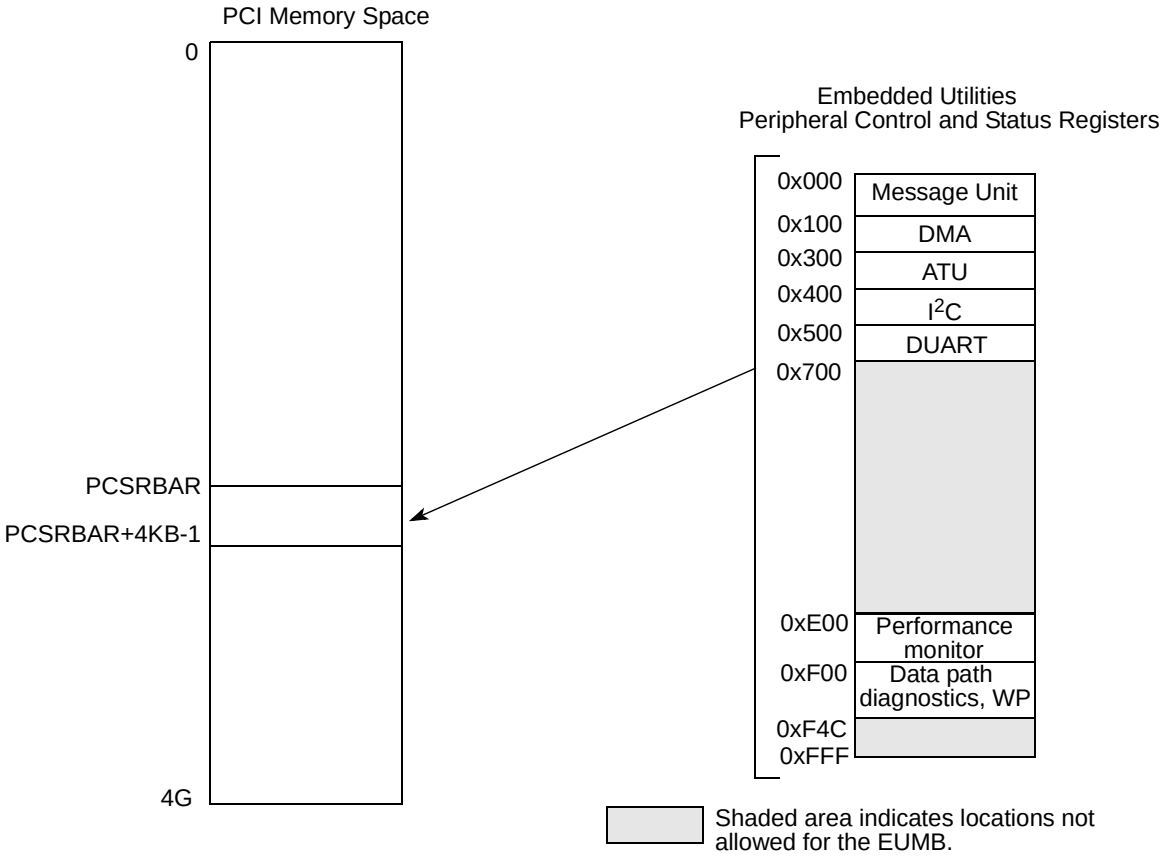


Figure 3-17. Embedded Utilities Memory Block Mapping to PCI Memory

Table 3-14 summarizes the embedded utilities registers accessible by the PCI bus and their offsets.

Table 3-14. Embedded Utilities Peripheral Control and Status Register Summary

PCI Memory Offset	Register Set	Reference
0x000 – 0x0FF	Message registers, doorbell interface, I_2O	Section 9.2.1, “Message and Doorbell Register Summary” and Section 9.3.2, “I2O Register Summary”
0x100 – 0x2FF	DMA controller	Section 8.2, “DMA Register Summary”
0x300 – 0x3FF	ATU	Section 3.3.4, “Address Translation Registers”
0x400 – 0x4FF	I^2C controller	Section 10.3, “I2C Register Descriptions”
0x500 – 0x6FF	DUART	Section 12.1.5, “DUART Register Summary”
0x700 – 0xDFF	Reserved	—
0xE00 – 0xEFF	Performance monitor	Section 16.2.3, “Performance Monitor Counter (PMC0–PMC3)”
0xF00 – 0xF17	Data path diagnostics	Section 17.1, “Debug Register Summary”
0xF18 – 0xF4B	Data path diagnostics and watchpoint registers	Chapter 18, “Programmable I/O and Watchpoint”
0xF4C – 0xFFF	Reserved	—

Chapter 4
Configuration Registers

This chapter describes the programmable configuration registers of the MPC8245. These registers are generally set up by initialization software after a power-on reset, hard reset, or error handling routine. All the configuration registers of the MPC8245 are intrinsically little-endian. In the register descriptions of this chapter, bit 0 is the least significant bit of the register. This bit numbering is based on the PCI standard for register bit order numbering and is opposite from big endian bit ordering in the PowerPC architecture. For big endian bit ordering, bit 0 is the most significant bit of the register.

Reserved bits in the register descriptions are not guaranteed to have predictable values. Software must preserve the values of reserved bits when writing to a configuration register. Also, when reading from a configuration register, software should not rely on the value of any reserved bit remaining consistent. Thus, the values of reserved bit positions must first be read, merged with the new values for other bit positions, and then written back. Software should use the transfer size shown in the register bit descriptions throughout this chapter.

4.1 Configuration Register Access

The MPC8245 configuration registers are accessible from the processor core through memory-mapped configuration ports. The registers are accessed by an indirect method similar to accessing PCI device configuration registers. A 32-bit register address 0x8000_00nn, where nn is the address offset of the desired configuration register (see Table 4-1 and Figure 4-1), is written to the CONFIG_ADDR port at any word-aligned address within the range 0xFEC0_0000–0xFEDF_FFFF. Then the data is accessed at the CONFIG_DAT port at 0xFEE0_0000–0xFEEF_FFFF. Note that every word within this range has an alias to the same location.

A subset of the configuration registers is accessible from the PCI bus through the use of PCI configuration transactions. The MPC8245 responds to standard PCI configuration transactions when its IDSEL signal is asserted. Table 4-2 provides a listing of configuration registers accessible from the PCI bus.

Note that the address loaded into CONFIG_ADDR is used as a word address and does not have byte granularity. Therefore, take care when accessing configuration registers that have a 1-or 2-byte size when the address of that register is not word-aligned. In this case, the **stb**

or **sth** instructions must use an <ea> with the appropriate offset for that byte or word, as shown in the following examples.

4.1.1 Configuration Register Access in Little-Endian Mode

When the processor and peripheral logic are in little-endian mode, the program should access the configuration registers using the method described in Section 4.1, “Configuration Register Access.” This section provides several examples of configuration register access in little-endian mode.

The configuration register address (CONFIG_ADDR) in the processor register should appear (as data appears) in descending byte order (MSB to LSB) when it is stored to the peripheral logic. The configuration data (CONFIG_DATA) appears in the processor register in descending significance byte order (MSB to LSB) at the time it is loaded or stored to the peripheral logic.

Example: Map B address map configuration sequence, 4-byte data write to register at address offset 0xA8

```
Initial values: r0 contains 0x8000_00A8
        r1 contains 0xFEC0_0000
        r2 contains 0xFEE0_0000
        r3 contains 0xAABB_CCDD
        Register at 0xA8 contains 0xFFFF_FFFF (AB to A8)

Code sequence:  stw     r0,0(r1)
                sync
                stw     r3,0(r2)
                sync

Results:Address 0xFEC0_0000 contains 0x8000_00A8 (MSB to LSB)
        Register at 0xA8 contains 0xAABB_CCDD (AB to A8)
```

Example: Map B address map configuration sequence, 1-byte data write to register at address offset 0xAA

```
Initial values: r0 contains 0x8000_00A8
        r1 contains 0xFEC0_0000
        r2 contains 0xFEE0_0000
        r3 contains 0xAABB_CCDD
        Register at 0xA8 contains 0xFFFF_FFFF (AB to A8)

Code sequence:  stw     r0,0(r1)
                sync
                stb     r3,2(r2)
                sync

Results:Address 0xFEC0_0000 contains 0x8000_00A8 (MSB to LSB)
        Register at 0xA8 contains 0xFFDD_FFFF (AB to A8)
```

4.1.2 Configuration Register Access in Big-Endian Mode

When the processor and peripheral logic are in big-endian mode, software must either use the load/store with byte reversed instructions (**lhbrx**, **lwbrx**, **sthbrx**, and **stwbrx**) or byte-swap the CONFIG_ADDR and CONFIG_DATA values before performing an access. That is, software loads the configuration register address and the configuration register data into the processor register in ascending byte order—LSB to MSB.

Note that in the following examples, the data in the configuration register (at 0xA8) is shown in little-endian order because all the internal registers are intrinsically little-endian.

Example: Map B address map configuration sequence, 4-byte data write to register at address offset 0xAA using store word with byte reversed instructions

```
Initial values:r0 contains 0x8000_00A8
        r1 contains 0xFEC0_0000
        r2 contains 0xFEE0_0000
        r3 contains 0xAABB_CCDD
        Register at 0xA8 contains 0xFFFF_FFFF (AB to A8)

Code sequence:  stwbrx  r0,0,r1
                sync
                stwbrx  r3,0,r2
                sync

Results:Address 0xFEC0_0000 contains 0x8000_00A8 (MSB to LSB)
Register at 0xA8 contains 0xAABB_CCDD (AB to A8)
```

Example: Map B address map configuration sequence, 2-byte data write to register at address offset 0xAA, using byte-swapped values in the processor registers

```
Initial values:r0 contains 0xA800_0080
        r1 contains 0xFEC0_0000
        r2 contains 0xFEE0_0000
        r3 contains 0xDDCC_BBAA
        Register at 0xA8 contains 0xFFFF_FFFF (AB to A8)

Code sequence:  stw     r0,0(r1)
                sync
                sth     r3,2(r2)
                sync

Results:Address 0xFEC0_0000 contains 0x8000_00A8 (MSB to LSB)
Register at 0xA8 contains 0xAABB_FFFF (AB to A8)
```

4.1.3 Configuration Register Summary

The following sections summarize the addresses and attributes of the configuration registers accessible by both the processor and the PCI interface.

4.1.3.1 Processor-Accessible Configuration Registers

Table 4-1 describes the configuration registers that are accessible by the processor core. Not all registers are shown in this document. Note that any configuration addresses not defined in Table 4-1 are reserved.

Table 4-1. Configuration Registers Accessible from the Processor Core

Address Offset	Register	Size (Bytes)	Program Access (Bytes)	Access	Reset Value
0x00	Vendor ID = 0x1057 (not shown)	2	2	Read	0x1057
0x02	Device ID = 0x0006(not shown)	2	2	Read	0x0006
0x04	PCI command register	2	2	Read/Write	mode-dependent 0x0004 host 0x0000 agent
0x06	PCI status register	2	2	Read/Bit Reset	0x00A0
0x08	Revision ID (not shown)	1	1	Read	0xnn
0x09	Standard programming interface	1	1	Read	mode-dependent 0x00 host 0x01 agent
0x0A	Subclass code (not shown)	1	1	Read	0x00
0x0B	Class code	1	1	Read	mode-dependent 0x06 host 0x0E agent
0x0C	Cache line size	1	1	Read/Write	0x00
0x0D	Latency timer	1	1	Read/Write	0x00
0x0E	Header type (not shown)	1	1	Read	0x00
0x0F	BIST control	1	1	Read	0x00
0x10	Local memory base address register 0	4	4	Read/Write	0x0000_0008
0x14	Peripheral control and status register base address register	4	4	Read/Write	0x0000_0000
0x18	Local memory base address register 1	4	4	Read/Write	0x0000_0008
0x2C	Subsystem Vendor ID	2	2	Read/Write	config setting
0x2E	Subsystem ID	2	2	Read/Write	config setting
0x30	Expansion ROM base address	4	4	Read	0x0000_0000
0x3C	Interrupt line	1	1	Read/Write	0x00
0x3D	Interrupt pin (not shown)	1	1	Read	0x01
0x3E	MIN GNT (not shown)	1	1	Read	0x00
0x3F	MAX LAT (not shown)	1	1	Read	0x00
0x40	Bus number (not shown)	1	1	Read/Write	0x00
0x41	Subordinate bus number (not shown)	1	1	Read/Write	0x00

Table 4-1. Configuration Registers Accessible from the Processor Core (continued)

Address Offset	Register	Size (Bytes)	Program Access (Bytes)	Access	Reset Value
0x44	PCI general control register	2	2	Read/Write	config setting
0x46	PCI arbiter control register	2	2	Read/Write	0x0000
0x70	Power management configuration register 1 (PMCR1)	2	1 or 2	Read/Write	0x00
0x72	Power management configuration register 2 (PMCR2)	1	1	Read/Write	0x00
0x73	Output driver control register	1	1	Read/Write	0xFF
0x74	CLK driver control register	2	1 or 2	Read/Write	0x0300
0x76	Miscellaneous driver control register 1	1	1	Read/Write	0x00
0x77	Miscellaneous driver control register 2	1	1	Read/Write	0x00
0x78	Embedded utilities memory block base address register	4	4	Read/Write	0x0000_0000
0x80, 0x84	Memory starting address registers	4	1, 2, or 4	Read/Write	0x0000_0000
0x88,0x 8C	Extended memory starting address registers	4	1, 2, or 4	Read/Write	0x0000_0000
0x90, 0x94	Memory ending address registers	4	1, 2, or 4	Read/Write	0x0000_0000
0x98, 0x9C	Extended memory ending address registers	4	1, 2, or 4	Read/Write	0x0000_0000
0xA0	Memory bank enable register	1	1	Read/Write	0x00
0xA3	Page mode counter/timer	1	1	Read/Write	0x00
0xA8	Processor interface configuration 1	4	1, 2, or 4	Read/Write	0x00n4_0010
0xAC	Processor interface configuration 2	4	1, 2, or 4	Read/Write	0x000C_000C
0xB8	ECC single bit error counter	1	1	Read/Bit Reset	0x00
0xB9	ECC single bit error trigger register	1	1	Read/Write	0x00
0xC0	Error enabling register 1	1	1	Read/Write	0x01
0xC1	Error detection register 1	1	1	Read/Bit Reset	0x00
0xC3	Processor internal bus error status register	1	1	Read/Bit Reset	0x00
0xC4	Error enabling register 2	1	1	Read/Write	0x00
0xC5	Error detection register 2	1	1	Read/Bit Reset	0x00
0xC7	PCI bus error status register	1	1	Read/Bit Reset	0x00
0xC8	Processor/PCI error address register	4	1, 2, or 4	Read	0x00
0xD0	Extended ROM configuration register 1	4	4	Read/Write	0xB5FF_8000
0xD4	Extended ROM configuration register 2	4	4	Read/Write	0xB5FF_8000

Table 4-1. Configuration Registers Accessible from the Processor Core (continued)

Address Offset	Register	Size (Bytes)	Program Access (Bytes)	Access	Reset Value
0xD8	Extended ROM configuration register 3	4	4	Read/Write	0x0C00_000E
0xDC	Extended ROM configuration register 4	4	4	Read/Write	0x0800_000E
0xE0	Address map B options register	1	1	Read/Write	0xC0
0xE2	PLL configuration register	1	1	Read	config setting
0xF0	MCCR1	4	1, 2, or 4	Read/Write	0xFFn2_0000
0xF4	MCCR2	4	1, 2, or 4	Read/Write	0x0000_0000
0xF8	MCCR3	4	1, 2, or 4	Read/Write	0x0000_0000
0xFC	MCCR4	4	1, 2, or 4	Read/Write	0x000_0000
others	Reserved	—	—	—	—

Note: Reset values marked mode-dependent are defined by whether the MPC8245 is operating in host or agent mode.

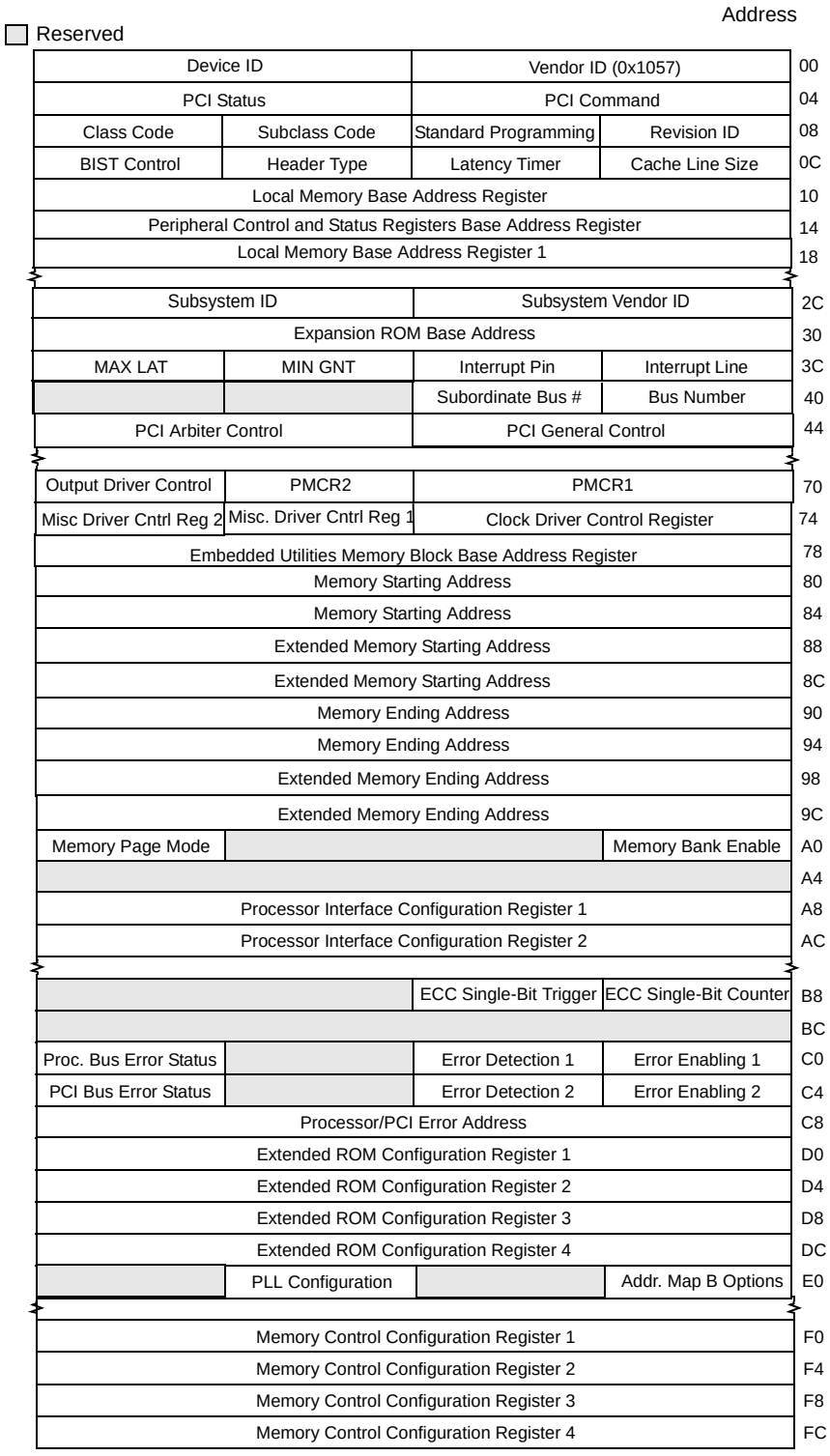


Figure 4-1. Processor Accessible Configuration Space

4.1.3.2 PCI-Accessible Configuration Registers

Table 4-2 lists the subset of configuration registers that are accessible from the PCI bus. Note that configuration addresses not defined in Table 4-2 are reserved.

Table 4-2. Configuration Registers Accessible from the PCI Bus

Address Offset	Register	Size (Bytes)	Program Access (Bytes)	Access	Reset Value
0x00	Vendor ID = 0x1057	2	2	Read	0x1057
0x02	Device ID = 0x0006	2	2	Read	0x0006
0x04	PCI command register	2	2	Read/Write	mode-dependent 0x0004 host 0x0000 agent
0x06	PCI status register	2	2	Read/Bit-Reset	0x00A0
0x08	Revision ID	1	1	Read	0xnn
0x09	Standard programming interface	1	1	Read	mode-dependent 0x00 host 0x01 agent
0x0A	Subclass code	1	1	Read	0x00
0x0B	Class code	1	1	Read	mode-dependent 0x06 host 0x0E agent
0x0C	Cache line size	1	1	Read/Write	0x00
0x0D	Latency timer	1	1	Read/Write	0x00
0x0E	Header type	1	1	Read	0x00
0x0F	BIST control	1	1	Read	0x00
0x10	Local memory base address register 0	4	4	Read/Write	0x0000_0008
0x14	Peripheral control and status register base address register	4	4	Read/Write	0x0000_0000
0x18	Local memory base address register 1	4	4	Read/Write	0x0000_0008
0x2C	Subsystem Vendor ID	2	2	Read/Write	config setting
0x2E	Subsystem ID	2	2	Read/Write	config setting
0x30	Expansion ROM base address	4	4	Read	0x0000_0000
0x3C	Interrupt line	1	1	Read/Write	0x00
0x3D	Interrupt pin	1	1	Read	0x01
0x3E	MIN GNT	1	1	Read	0x00
0x3F	MAX LAT	1	1	Read	0x00
0x44	PCI general control register	2	2	Read/Write	config setting
0x46	PCI arbiter control register	2	2	Read/Write	0x0000

Table 4-2. Configuration Registers Accessible from the PCI Bus (continued)

Address Offset	Register	Size (Bytes)	Program Access (Bytes)	Access	Reset Value
Others	Reserved	—	—	—	—

Note: Reset values marked mode-dependent are defined by whether the MPC8245 is operating in host or agent mode.

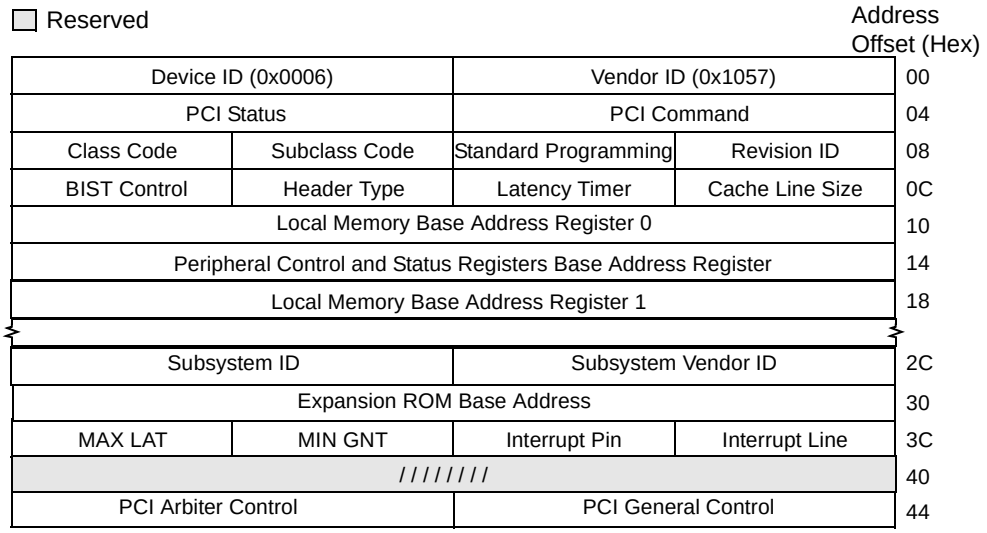


Figure 4-2. PCI Accessible Configuration Space

4.2 PCI Interface Configuration Registers

The *PCI Local Bus Specification* defines the configuration registers from 0x00 through 0x3F. Table 4-3 summarizes the PCI configuration registers of the MPC8245. Detailed descriptions of these registers are provided in the *PCI Local Bus Specification.*

Table 4-3. PCI Configuration Space Header Summary

Address Offset	Register Name	Description
0x00	Vendor ID	Identifies the manufacturer of the device (0x1057 = Motorola)
0x02	Device ID	Identifies the particular device (0x0006 = MPC8245).
0x04	PCI command	Provides coarse control over a device's ability to generate and respond to PCI bus cycles (see Section 4.2.1, "PCI Command Register—Offset 0x04," for more information)
0x06	PCI status	Records status information for PCI bus-related events (see Section 4.2.2, "PCI Status Register—Offset 0x06," for more information)
0x08	Revision ID	Specifies a device-specific revision code (assigned by Motorola)
0x09	Standard programming interface	Identifies the register-level programming interface of the MPC8245

Table 4-3. PCI Configuration Space Header Summary (continued)

Address Offset	Register Name	Description
0x0A	Subclass code	Identifies more specifically the function of the MPC8245
0x0B	Base class code	Broadly classifies the type of function the MPC8245 performs (Host mode = 0x06 bridge device, Agent mode = 0x0E intelligent I/O controller)
0x0C	Cache line size	Specifies the system cache line size
0x0D	Latency timer	Specifies the value of the latency timer for this bus master in PCI bus clock units
0x0E	Header type	Bits 0–6 identify the layout of bytes 10–3F; bit 7 indicates a multifunction device. The MPC8245 uses the most common header type (0x00).
0x0F	BIST control	Optional register for control and status of built-in self test (BIST)
0x10–0x2F	—	Reserved on the MPC8245
0x30	Expansion ROM base address	This register is read-only. The default value has 0b0 in bit 0, defining the expansion ROM base address register as disabled in the MPC8245.
0x34–0x3B	—	Reserved for future use by PCI
0x3C	Interrupt line	Contains interrupt line routing information
0x3D	Interrupt pin	Indicates which interrupt pin the device (or function) uses (0x00 = no interrupt pin)
0x3E	MIN GNT	Specifies the length of the device's burst period (0x00 indicates that the MPC8245 has no major requirements for the settings of latency timers.)
0x3F	MAX LAT	Specifies how often the device needs to gain access to the PCI bus (0x00 indicates that the MPC8245 has no major requirements for the settings of latency timers)
0x43	—	Reserved on the MPC8245

System software may need to scan the PCI bus to determine what devices are actually present. To do this, the configuration software must read the vendor ID in each possible PCI slot. If a read of an empty slot gets no response, the MPC8245 returns 0xFFFF (the invalid vendor ID). Any configuration write cycle to a reserved register is completed normally and the data is discarded.

4.2.1 PCI Command Register—Offset 0x04

The following subsections describe the MPC8245 PCI configuration registers in detail.

The 2-byte PCI command register, shown in Figure 4-3, provides control over the ability to generate and respond to PCI cycles. Table 4-4 describes the bits of the PCI command register.

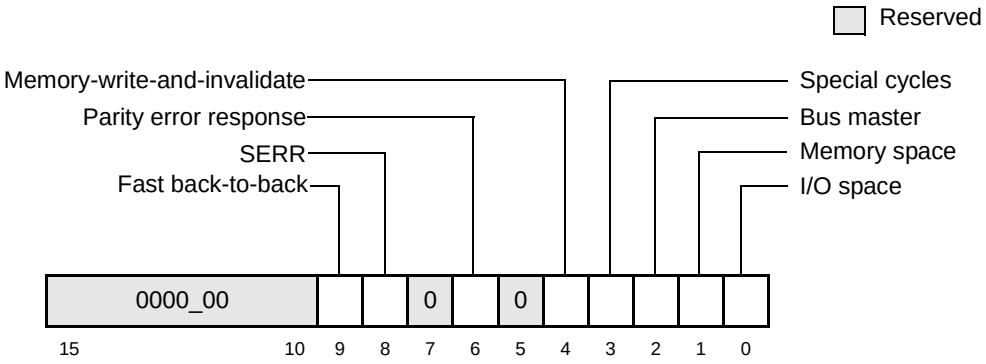


Figure 4-3. PCI Command Register—0x04

The 2-byte PCI status register, shown in Figure 4-4, is used to record status information for PCI bus-related events. The definition of each bit is given in Table 4-5. Only 2-byte accesses to address offset 0x06 are allowed.

Table 4-4. Bit Settings for PCI Command Register—0x04

Bits	Name	Reset Value	Description
15–10	—	All 0s	Reserved
9	Fast back-to-back	0	This bit is hardwired to 0, indicating that the MPC8245 does not run fast back-to-back transactions.
8	SERR	0	This bit controls the $\overline{\text{SERR}}$ driver of the MPC8245. This bit (and bit 6) must be set to report address parity errors. 0 Disables the $\overline{\text{SERR}}$ driver 1 Enables the $\overline{\text{SERR}}$ driver
7	—	0	Reserved
6	Parity error response	0	This bit controls whether the MPC8245 responds to parity errors. 0 Parity errors are ignored and normal operation continues. 1 Action is taken on a parity error. See Chapter 14, “Error Handling,” for more information.
5	—	0	Reserved
4	Memory-write-and-invalidate	0	This bit enables generation of the memory-write-and-invalidate command by the MPC8245 as a master. 0 Memory-write command used by MPC8245. 1 Memory-write-and-invalidate command used by MPC8245.
3	Special cycles	0	This bit is hardwired to 0, indicating that the MPC8245 (as a target) ignores all special-cycle commands.
2	Bus master	1 (host) 0 (agent)	This bit controls whether the MPC8245 can act as a master on the PCI bus. Note that if this bit is cleared, processor-to-PCI writes cause the data to be held until it is enabled. Processor to PCI reads with master disabled cause a machine check exception (if enabled). 0 Disables the ability to generate PCI accesses 1 Enables the MPC8245 to behave as a PCI bus master

Table 4-4. Bit Settings for PCI Command Register—0x04 (continued)

Bits	Name	Reset Value	Description
1	Memory space	0	This bit controls whether the MPC8245 (as a target) responds to memory accesses. 0 The MPC8245 does not respond to PCI memory space accesses. 1 The MPC8245 responds to PCI memory space accesses.
0	I/O space	0	This bit is hardwired to 0, indicating that the MPC8245 (as a target) does not respond to PCI I/O space accesses.

4.2.2 PCI Status Register—Offset 0x06

The 2-byte PCI status register, shown in Figure 4-4, records status information for PCI bus-related events. The definition of each bit is given in Table 4-5. Only 2-byte accesses to address offset 0x06 are allowed.

Reads to this register behave normally. Writes are slightly different in that bits can be cleared, but not set. A bit is cleared whenever the register is written and the data in the corresponding bit location is a 1. For example, to clear bit 14 and not affect any other bits in the register, write the value 0b0100_0000_0000_0000 to the register.

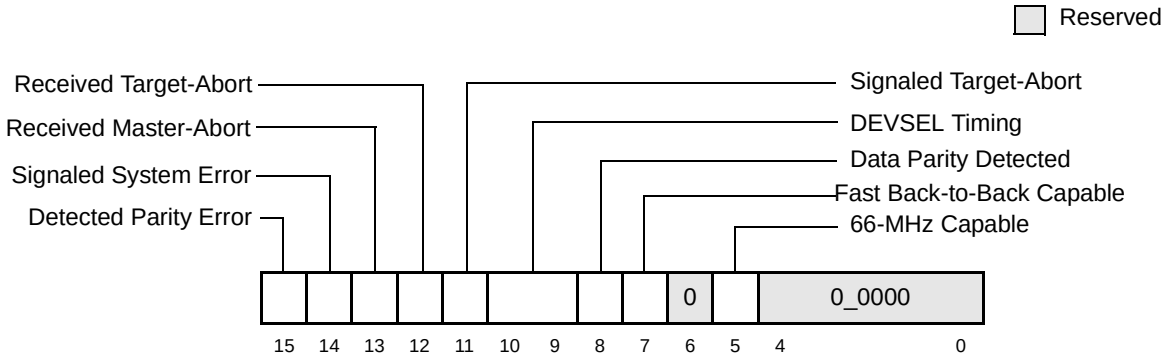


Figure 4-4. PCI Status Register—0x06

Table 4-5 describes the bit settings for the PCI status register.

Table 4-5. Bit Settings for PCI Status Register—0x06

Bits	Name	Reset Value	Description
15	Detected parity error	0	This bit is set whenever the MPC8245 detects an address or data parity error, even if parity error handling is disabled (as controlled by bit 6 in the PCI command register).
14	Signaled system error	0	This bit is set whenever the MPC8245 asserts $\overline{\text{SERR}}$.
13	Received master-abort	0	This bit is set whenever the MPC8245, acting as the PCI master, terminates a transaction (except for a special-cycle) using master-abort.

Table 4-5. Bit Settings for PCI Status Register—0x06 (continued)

Bits	Name	Reset Value	Description
12	Received target-abort	0	This bit is set whenever an MPC8245-initiated transaction is terminated by a target-abort.
11	Signaled target-abort	0	This bit is set whenever the MPC8245, acting as the PCI target, issues a target-abort to a PCI master.
10–9	DEVSEL timing	00	These bits are hardwired to 0b00, indicating that the MPC8245 uses fast device select timing.
8	Data parity detected	0	This bit is set upon detecting a data parity error. Three conditions must be met for this bit to be set: The MPC8245 detected a parity error. MPC8245 was acting as the bus master for the operation in which the error occurred. Bit 6 (parity error response) in the PCI command register was set.
7	Fast back-to-back capable	1	This bit is hardwired to 1, indicating that the MPC8245 (as a target) is capable of accepting fast back-to-back transactions.
6	—	0	Reserved
5	66-MHz capable	1	This bit is read-only and indicates that the MPC8245 is capable of 66-MHz PCI bus operation.
4–0	—	0_0000	Reserved

4.2.3 Programming Interface—Offset 0x09

Table 4-6 describes the PCI programming interface register (PIR).

Table 4-6. Programming Interface—0x09

Bits	Reset Value	Description
msb 7–0	Mode-dependent	0x00 When MPC8245 is configured as host bridge 0x01 When MPC8245 is configured as an agent device to indicate the programming model supports the I_2O interface

4.2.4 PCI Base Class Code—Offset 0x0B

Table 4-7 describes the PCI base class code register (PBCCR).

Table 4-7. PCI Base Class Code—0x0B

Bits	Reset Value	Description
msb 7–0	Mode-dependent	0x06 When MPC8245 is configured as a host bridge to indicate 'host bridge.' 0x0E When MPC8245 is configured as a target device to indicate the device is an agent and is I_2O capable.

4.2.5 PCI Cache Line Size—Offset 0x0C

Table 4-8 describes the processor cache line size register (PCLSR).

Table 4-8. Cache Line Size Register—0x0C

Bits	Reset Value	Description
msb 7–0	0x00	Represents the cache line size of the processor in terms of 32-bit words (eight 32-bit words = 32 bytes). This register is read-write; however, an attempt to program this register to any value other than 8 results in setting it to 0.

4.2.6 Latency Timer—Offset 0x0D

Table 4-9 describes the PCI latency timer register (PLTR).

Table 4-9. Latency Timer Register—0x0D

Bits	Reset Value	Description
msb 7–3	0000_0	The maximum number of PCI clocks for which the MPC8245 (while mastering a transaction), will hold the bus after the PCI bus grant has been negated. The entire value in this register represents the total latency in PCI clocks. Thus the total latency is the value in bits 7–3 multiplied by 8 (because bits 2–0 are read-only as zeros). Refer to the PCI 2.2 specification for the rules by which the PCI bus interface unit completes transactions when the timer has expired.
2–0	000	Read-only bits. Because these bits are read-only as zeros, the granularity of the latency timer value is 8 PCI clocks.

4.2.7 PCI Base Address Registers—LMBAR*n* and PCSRBAR

The following three base address registers are provided when the MPC8245 is used in the PCI agent mode:

- Two local memory base address registers (LMBAR0 and LMBAR1)
- One peripheral control and status registers base address register (PCSRBAR)

These registers allow a host processor to configure the base addresses of the MPC8245 when the MPC8245 is being used as a PCI agent. The use of these memory spaces is optional and selectable by the processor. The processor core configures the local memory

and enables the embedded utilities before the host software is allowed to complete PCI configuration. See Chapter 3, “Address Maps,” for more information on the use of the embedded utilities and the address translation functionality of the MPC8245.

Table 4-10 describes the bit settings for the LMBAR.

Table 4-10. Local Memory Base Address Register Bit Definitions—Offsets 0x10, 0x18

Bits	Name	Reset Value	R/W	Description
31–12	Inbound memory base address	0x0000_0	R/W	Indicates the base address where the inbound memory window resides. The inbound memory window should be aligned based on the granularity specified by the inbound window size specified in the ITWR*n*. Note that the EUMB area must be selected first, then the ITWR*n* programmed, and then the bits set. Refer to Chapter 3, “Address Maps,” for more information on the EUMB and the ATU.
11–4	Reserved	All 0s	R	Reserved; the MPC8245 only allows a minimum of a 4-Kbyte window.
3	Prefetchable	1	R	Indicates that the space is prefetchable.
2–1	Type	00	R	The inbound memory window may be located anywhere within the 32-bit PCI address space.
0	Memory space indicator	0	R	Indicates PCI memory space

Table 4-11 describes the PCSRBAR.

Table 4-11. PCSR Base Address Register Bit Definitions—0x14

Bits	Reset Value	R/W	Description
msb 31–12	0x0000_0	R/W	Indicates the PCI base address that is mapped to the runtime registers (for example, DMA, I_2O).
11–0	0x000	R	Reserved

4.2.8 Subsystem Vendor ID—Offset 0x2C

Table 4-12 describes the subsystem vendor ID register.

Table 4-12. Subsystem Vendor ID—0x2C

Bits	Reset Value	Description
msb 15–0	x [1]	Value is determined at startup through configuration pins MDH[16:31] but can be programmed by software after reset.

1 Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.2.9 Subsystem ID—Offset 0x2E

Table 4-13 describes the subsystem ID register.

Table 4-13. Subsystem ID—0x2E

Bits	Reset Value	Description
msb 15–0	x [1]	Value is determined at startup through configuration pins MDH[0:15] but can be programmed by software after reset.

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.2.10 PCI Interrupt Line—Offset 0x3C

Table 4-14 describes the PCI interrupt line register (ILR).

Table 4-14. Interrupt Line Register—0x3C

Bits	Reset Value	Description
msb 7–0	0x00	Contains the interrupt routing information. Software can use this register to hold information regarding on which input of the system interrupt controller corresponds to the $\overline{\text{INTA}}$ signal. Values in this register are system-architecture-specific.

4.2.11 PCI General Control Register (PGCR)—Offset 0x44

Table 4-15 describes the bit settings for the PCI general control register.

Table 4-15. PCI General Control Register Bit Definitions—0x44

Bits	Reset Value	R/W	Description
msb 15–6	All 0s	R	Reserved
5	0	R/W	Controls ability to retry all incoming PCI read transactions to local memory while the processor core is writing data to the PCI bus (for example, while internal buffers have data to be written to the PCI bus). 0 Disables ability to retry all incoming PCI memory read transactions to local memory while the processor core is writing data to the PCI bus 1 Enables ability to retry all incoming PCI memory read transactions to local memory while the processor core is writing data to the PCI bus
4	x [1]	R/W	Controls $\overline{\text{LOCK}}$ support and is software programmable. 0 This bit is cleared by default when the MPC8245 is in host mode. Enables $\overline{\text{LOCK}}$ support only if the MPC8245 is the target of a locked transaction. 1 This bit is set by default when the MPC8245 is in agent mode. Disables $\overline{\text{LOCK}}$ support. All locked transactions are treated as non-locked transactions.
3	0	R	Reserved

Table 4-15. PCI General Control Register Bit Definitions—0x44 (continued)

Bits	Reset Value	R/W	Description
2–1	00	R/W	Subsequent latency timer disconnect count. The MPC8245 will issue a disconnect if the MPC8245, as a target, cannot provide data from PCI masters with in the clock interval indicated below. The MPC8245 PCI is a 2.2 compatible device. 00 Disconnect issued after 8 PCI clocks 01 Disconnect issued after 16 PCI clocks 10 Disconnect issued after 32 PCI clocks 11 Disconnect issued after 64 PCI clocks
0	0	R	Reserved

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.2.12 PCI Arbiter Control Register (PACR)—Offset 0x46

This register controls the on-chip arbitration for external PCI masters. As many as five external devices are supported.

Table 4-16 describes the bit settings for the PCI arbiter control register.

Table 4-16. PCI Arbiter Control Register Bit Definitions—0x46

Bits	Reset Value	R/W	Description
msb 15	x [1]	R/W	Enable on-chip PCI arbitration. 0 If cleared, the on-chip arbiter for external PCI masters is disabled, and the MPC8245 presents its request on $\overline{\text{GNT0}}$ to the external arbiter and receives its grant on $\overline{\text{REQ0}}$. 1 If set, indicates the on-chip arbiter is enabled. The state of this bit coming out of hard reset is determined by pin MAA2 but can be programmed by software after reset.
14–13	00	R/W	Parking mode controls which device receives the bus grant when there are no outstanding bus requests and the bus is idle. 00 The bus is parked with the last device to use the bus. 01 The bus is parked with the device using $\overline{\text{REQ0}}$ and $\overline{\text{GNT0}}$. 10 The bus is parked with MPC8245. 11 Reserved; do not use.
12	0	R/W	PCI broken master disable. This bit controls whether the PCI arbiter negates the bus grant to a requesting master that does not assert $\overline{\text{FRAME}}$ within 16 PCI clock cycles from the time the bus is idle. 0 PCI arbiter negates the PCI $\overline{\text{GNT}x}$ signal to a requesting master that does not begin using the bus (by asserting FRAME) within 16 PCI clock cycles from the time the PCI clock is idle. 1 A PCI master that has been granted the bus never loses its grant until (and unless) it begins a transaction or negates the $\overline{\text{REQ}x}$ signal. It is recommended that this bit stay cleared.
11	0	R	Reserved
10	0	R/W	Retry PCI Configuration Cycle 1 PCI target logic retries all external PCI configuration transactions. 0 PCI target logic responds to external PCI configuration transactions.

Table 4-16. PCI Arbiter Control Register Bit Definitions—0x46 (continued)

Bits	Reset Value	R/W	Description
9–8	00	R	Reserved
7	0	R/W	MPC8245 priority level, 1 = high, 0 = low
6–5	00	R	Reserved
4–0	0_0000	R/W	External device priority levels, 1 = high, 0 = low. Bit 0 corresponds to the device using $\overline{\text{REQ0}}$ and $\overline{\text{GNT0}}$, bit 1 to $\overline{\text{REQ1}}$ and $\overline{\text{GNT1}}$, etc.

1 Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.3 Peripheral Logic Power Management Configuration Registers (PMCRs)

The power management configuration registers (PMCRs) control the power management functions of the peripheral logic. For more information on the power management feature of both the processor core and the peripheral logic, see Chapter 15, “Power Management.”

4.3.1 Power Management Configuration Register 1 (PMCR1)—Offset 0x70

Power management configuration register 1 (PMCR1), shown in Figure 4-5, is a 2-byte register located at offset 0x70.

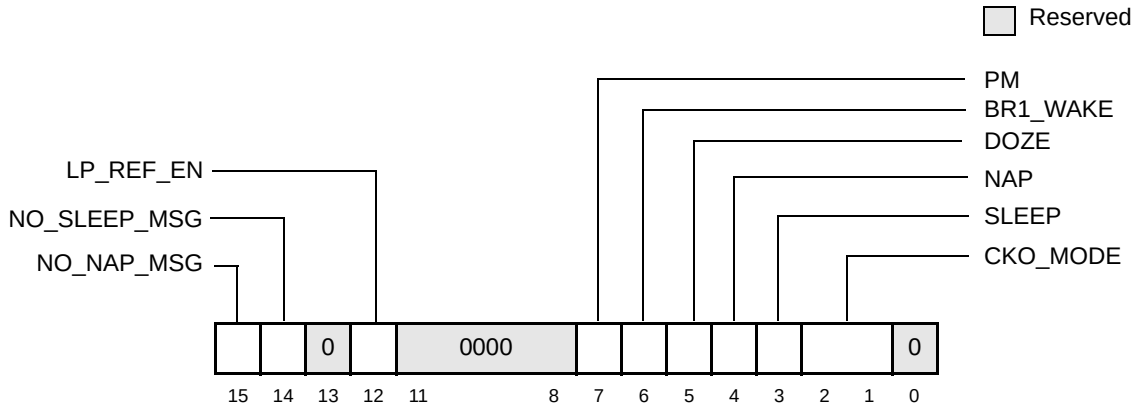


Figure 4-5. Power Management Configuration Register 1 (PMCR1)—0x70

Table 4-17 describes the bits of PMCR1.

Table 4-17. Bit Settings for Power Management Configuration Register 1—0x70

Bits	Name	Reset Value	Description
15	NO_NAP_MSG	0	HALT command broadcast. Not supported on the MPC8245. 1 Initialization software must set this bit, indicating that the MPC8245 does not broadcast a HALT command on the PCI bus before entering the nap mode.
14	NO_SLEEP_MSG	0	Sleep message broadcast. Not supported on the MPC8245. 1 Initialization software must set this bit, indicating that the MPC8245 does not broadcast a sleep message command on the PCI bus before entering the sleep mode.
13	—	0	Reserved
12	LP_REF_EN	0	Low-power refresh 0 Indicates that the MPC8245 does not perform memory refresh cycles when it is in sleep mode 1 Indicates that the MPC8245 continues to perform memory refresh cycles when in sleep mode
11–8	—	0	Reserved
7	PM	0	Power management enable 0 Disables the peripheral logic power management logic within the MPC8245 1 Enables the peripheral logic power management logic within the MPC8245
6	BR1_WAKE	0	$\overline{\text{BR1}}$ wake. Enables power management wake-up from second processor on peripheral bus. 0 $\overline{\text{BR1}}$ is ignored during nap and sleep modes. 1 Assertion of $\overline{\text{BR1}}$ causes the MPC8245 to wake up from nap or sleep mode (used in multiprocessor systems).
5	DOZE	0	Enables/disables the doze mode capability of the MPC8245. Note that this bit is only valid if MPC8245 power management is enabled. (PMCR1[PM] = 1). 0 Disables the doze mode 1 Enables the doze mode
4	NAP	0	Enables/disables the nap mode capability of the MPC8245. Note that this bit is only valid if MPC8245 power management is enabled. (PMCR1[PM] = 1). 0 Disables the nap mode 1 Enables the nap mode
3	SLEEP	0	Enables/disables the sleep mode capability of the MPC8245. Note that this bit is only valid if MPC8245 power management is enabled. (PMCR1[PM] = 1). 0 Disables the sleep mode 1 Enables the sleep mode

Table 4-17. Bit Settings for Power Management Configuration Register 1—0x70

Bits	Name	Reset Value	Description
2–1	CKO_MODE	00	Selects the clock source for the test clock output when CKO_SEL = 1. 00 Disables the test clock output driver 01 Selects the internal *sys_logic_clk* signal as the test clock output source 10 Selects one-half of the PCI rate clock as the test clock output source 11 Selects the internal PCI rate clock as the test clock output source
0	CKO_SEL	x [1]	The initial value of this bit is determined by the $\overline{AS}$ reset configuration bit, which selects either the clock output of the processor core or the clock output of the system logic to be driven out of the CKO signal. 0 Processor core clock selected. The signal driven by CKO is determined by HID0[ECLK,SBCLK]. See Section 5.3.1.2.1, “Hardware Implementation-Dependent Register 0 (HID0),” for the available choices. 1 System logic clock selected. The signal driven by CKO is determined by the encoding of the CKO_MODE bits above. See CKO_MODE field description for the available choices.

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.3.2 Power Management Configuration Register 2 (PMCR2)—Offset 0x72

Power management configuration register 2 (PMCR2), shown in Figure 4-6, is a 1-byte register located at offset 0x72.

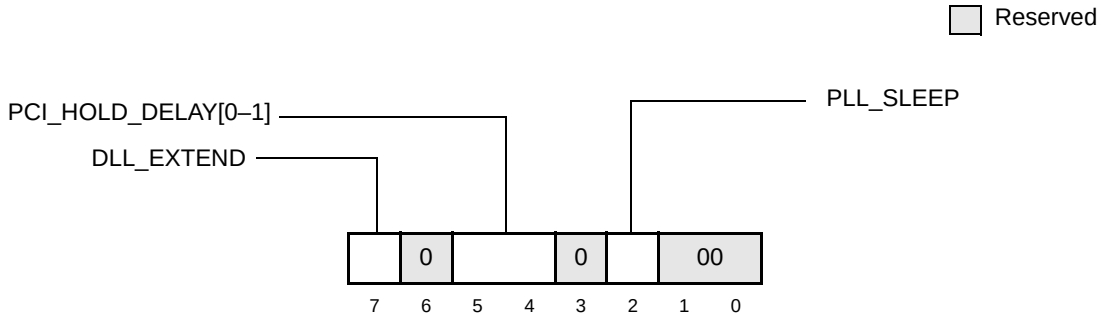


Figure 4-6. Power Management Configuration Register 2 (PMCR2)—0x72

Table 4-18 describes the bits of PMCR2.

Table 4-18. Power Management Configuration Register 2—0x72

Bits	Name	Reset Value	Description
msb 7	DLL_EXTEND	0	This bit can be used to shift the lock-range of the DLL by half of a PCI clock cycle. See the *MPC8245 Integrated Processor Hardware Specifications* for more information on the use of the DLL extend feature. 0 Standard (non-extended) range 1 DLL extended range
6	—	0	Reserved
5–4	PCI_HOLD_DEL	xx [1]	PCI output hold delay value relative to the PCI_SYNC_IN signal. See the *MPC8245 Integrated Processor Hardware Specifications* for the detailed number of nanoseconds guaranteed for each setting. There are four sequential settings for this value; each corresponds to a set increase in hold time: 00 Recommended for 66 MHz PCI bus (default) 01 10 Recommended for 33 MHz PCI bus 11 The initial values of bits 5 and 4 are determined by the inverse of $\overline{\text{MCP}}$ and CKE reset configuration signals, respectively. See Section 2.4, “Configuration Signals Sampled at Reset,” for more information. As these two pins have internal pull-up resistors, the default value after reset is 0b00.
3	—	0	Reserved
2	PLL_SLEEP	0	PLL sampling when waking from sleep mode 0 The MPC8245 does not sample the PLL configuration pins 1 The MPC8245 samples the PLL configuration pins
1–0	—	0	Reserved

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.4 Output/Clock Driver and Miscellaneous I/O Control Registers

Table 4-19 describes the general output driver control available with the MPC8245 through the output driver control register (ODCR), and Table 4-20 describes the output enable/disable capability available for the clock signals through the clock driver control register (CDCR). Table 4-21 describes miscellaneous I/O control register 1 (MIOCR1), which controls the type of output for the $\overline{\text{MCP}}$, $\overline{\text{SRESET}}$ and $\overline{\text{QACK}}$ signals. Table 4-22 describes miscellaneous I/O control register 2 (MIOCR2), which controls the memory interface input setup and hold times.

Note that the output drive of the $\overline{\text{RCS2}}$ signal is hardwired to 6 ohms and the output drive of the $\overline{\text{MIV}}$ signal is hardwired to 40 ohms.

Output driver control allows for impedance matching of electrical signals. When driving a capacitive load and the polarity of the driving signal is reversed, the maximum current driven by the output driver of a pin occurs during the transition of the signal. The output driver strength must be configured to match the load impedance. The matched impedance limits the maximum current driven during signal transitions. The transition current and mismatched impedance cause ringing on the signal. If the driver level is set too strong, the ringing intensifies. For more information on the output driver type for each signal, refer to the *MPC8245 Integrated Processor Hardware Specifications*.

Table 4-19. Output Driver Control Register Bit Definitions—0x73

Bits	Name	Reset Value	Description
msb 7	DRV_PCI	x [1]	Driver capability for the PCI and PIC controller output signals. 0 20 Ω drive capability on AD[31:0], C/BE[3:0], DEVSEL, FRAME, GNT[4:0], PAR, INTA, IRDY, PERR, SERR, STOP, TRDY, IRQ0/S_INT, IRQ1/S_CLK, and IRQ4/L_IN signals and 6 Ω drive capability on IRQ2/S_RST and IRQ3/S_FRAME 1 40 Ω drive capability on PCI/PIC signals The initial value of this bit is determined by the PMAA2 reset configuration pin.
6	—	1	Reserved [2]
5–4	DRV_MEM_CTRL[1–2]	xx[1]	Driver capability for the standard and memory signals (CS[0:7], DQM[0:7], WE, FOE, RCS0, RCS1, SDBA[1:0], SDRAS, SDCAS, CKE, AS, SDMA[11:0], CHKSTOP_IN, SRESET, TBEN, RCS3/TRIG_OUT, PMAA[0:2], SDA, SCL, CKO, QACK, DA[10:6], MCP, MDH[0:31], MDL[0:31], PAR[0:7], and MAA[0:2]). Controls drive strength of SDRAM_CLK[0:3] and SDRAM_SYNC_OUT for silicon revisions 1.0 and 1.1. DRV_MEM_CTRL[1–2]: 00 reserved 01 40-Ω drive capability for all standard and memory signals (including the SDRAM_SYNC_OUT and SDRAM clocks of part revisions 1.0 and 1.1). 10 20-Ω drive capability for all standard and memory signals (including the SDRAM_SYNC_OUT and SDRAM clocks of part revisions 1.0 and 1.1). 11 20-Ω drive capability for the following standard and memory signals: PMAA[0:2], SDA, SCL, CKO, QACK, DA[10:6], MCP, MDH[0:31], MDL[0:31], PAR[0:7], and MAA[0:2]; 6-Ω drive capability for all other memory signals (including the SDRAM_SYNC_OUT and SDRAM clocks of part revisions 1.0 and 1.1). The initial value of DRV_MEM_CTRL[1–2] is determined by the PMAA0 and PMAA1 reset configuration pins, respectively.

Table 4-19. Output Driver Control Register Bit Definitions—0x73 (continued)

Bits	Name	Reset Value	Description
3–2	DRV_PCI_CLK[1–2]	1	Controls drive strength of PCI_CLK[0:4] and PCI_CLK_SYNC_OUT. DRV_PCI_CLK[1–2]: 00 reserved 01 40-Ω drive capability 10 20-Ω drive capability 11 6-Ω drive capability
1–0	DRV_MEM_CLK_[1–2]	11	Controls drive strength of SDRAM_CLK[0:3] and SDRAM_SYNC_OUT for silicon revision 1.2 DRV_MEM_CLK_[1–2]: 00 reserved 01 40-Ω drive capability 10 20-Ω drive capability 11 6-Ω drive capability

1 See Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

2 See chip errata #19.

Table 4-20. CLK Driver Control Register Bit Definitions—0x74

Bit	Name	Reset Value	Description
15	PCI_SYNC_OUT	0	This bit disables/enables the PCI_SYNC_OUT signal of the MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
14	PCI_CLK0_DIS	0	This bit disables/enables the PCI_CLK0 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
13	PCI_CLK1_DIS	0	This bit disables/enables the PCI_CLK1 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
12	PCI_CLK2 _DIS	0	This bit disables/enables the PCI_CLK2 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
11	PCI_CLK3_DIS	0	This bit disables/enables the PCI_CLK3 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
10	PCI_CLK4_DIS	0	This bit disables/enables the PCI_CLK4 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
9–8	—	00	Reserved
7	—	0	Reserved
6	SDRAM_CLK0_DIS	0	This bit disables/enables the SDRAM_CLK0 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
5	SDRAM_CLK1_DIS	0	This bit disables/enables the SDRAM_CLK1 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
4	SDRAM_CLK2_DIS	0	This bit disables/enables the SDRAM_CLK2 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.

Table 4-20. CLK Driver Control Register Bit Definitions—0x74 (continued)

Bit	Name	Reset Value	Description
3	SDRAM_CLK3_DIS	0	This bit disables/enables the SDRAM_CLK3 output of MPC8245. A value of one (0b1) disables the output. A value of zero (0b0) enables the output.
2–0	—	000	Reserved

Table 4-21. Miscellaneous I/O Control Register 1 Bit Definitions—0x76

Bits	Name	Reset Value	Description
7	MCP_OD_MODE	0	This bit can be used to internally configure the $\overline{\text{MCP}}$ output as open-drain. Note that $\overline{\text{MCP}}$ is an output from peripheral to CPU block. 0 $\overline{\text{MCP}}$ is always driven 1 $\overline{\text{MCP}}$ is open-drain
6	—	0	Reserved
5–3	—	All 0s	Reserved
2	DLL_MAX_DELAY	0	This bit can be used to set the delay line length. Please see Section 2.3.2, “DLL Operation and Locking,” for more information. 1 DLL_max_mode, longer DLL delay line length 0 shorter (or normal) DLL delay line length
1	CLK_FLIP	x [1]	Read only. This bit indicates the inverse of the clock-flip disable ($\overline{\text{QACK}}$) configuration signal during reset. See 2.3.3, “Clock Synchronization,” for more information on the use of clock flipping. 0 Clock flipping is disabled, $\overline{\text{QACK}}$ is pulled high at reset 1 Clock flipping is enabled, $\overline{\text{QACK}}$ is pulled low at reset
	—	00	Reserved

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

Table 4-22. Miscellaneous I/O Control Register 2 Bit Definitions—0x77

Bits	Name	Reset Value	Description
7–6	—	00	Reserved
5–4	SDRAM_DSCD	10	SDRAM data in sample clock delay. These bits are used to select the desired minimum SDRAM_SYNC_IN input setup and hold times. The setup time increases as the field value decreases and hold time decreases as the field decreases. See the *MPC8245 Integrated Processor Hardware Specifications* for more information on the setting of these bits.
3–0	—	000	Reserved

4.5 Embedded Utilities Memory Block Base Address Register—0x78

The embedded utilities memory block base address register (EUMBBAR), shown in Table 4-23, controls the placement of the embedded utilities memory block (EUMB). See Section 3.4, “Embedded Utilities Memory Block (EUMB).”

Table 4-23. Embedded Utilities Memory Base Address Register—0x78

Bits	Name	Reset Value	Description
msb 31–20	Base Address	0x000	Base address of the embedded memory utilities block. The block size is 1 Mbyte, and its base address is aligned naturally to a 1 Mbyte address boundary (so the base address is 0xXXX0_0000). This block is used by processor-initiated transactions and should be located within PCI memory space. Registers within the EUMB are located from 0x8000_0000 to 0xFDFF_FFFF**.** Thus, valid values are 0x800–0xFDF. Otherwise, the EUMB is effectively disabled.
19–0	—	0x0_0000	Reserved

4.6 Memory Interface Configuration Registers

The memory interface configuration registers (MICRs) control memory boundaries (starting and ending addresses), memory bank enables, memory timing, and external memory buffers. Initialization software must program the MICRs at reset and then enable the memory interface on the MPC8245 by setting the MEMGO bit in memory control configuration register 1 (MCCR1).

4.6.1 Memory Boundary Registers

The extended starting address and the starting address registers are used to define the lower address boundary for each memory bank. The lower boundary is determined by the following formula:

```
Lower boundary for bank n = 0b0 || <extended starting address n> || <starting address n> || 0x0_0000.
```

The extended ending address and the ending address registers are used to define the upper address boundary for each memory bank. The upper boundary is determined by the following formula:

```
Upper boundary for bank n = 0b0 || <extended ending address n> || <ending address n> || 0xF_FFFF.
```

Figure 4-7, Figure 4-8, and Table 4-24 depict the memory starting address register 1 and 2 bit settings.

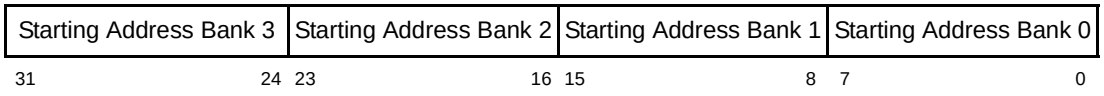


Figure 4-7. Memory Starting Address Register 1—0x80

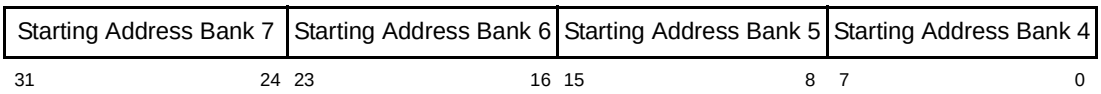


Figure 4-8. Memory Starting Address Register 2—0x84

Table 4-24. Bit Settings for Memory Starting Address Registers 1 and 2

Bits	Name	Reset Value	Description	Word Address
31–24	Starting address bank 3	0x00	Starting address for bank 3	0x80
23–16	Starting address bank 2	0x00	Starting address for bank 2	
15–8	Starting address bank 1	0x00	Starting address for bank 1	
7–0	Starting address bank 0	0x00	Starting address for bank 0	
31–24	Starting address bank 7	0x00	Starting address for bank 7	0x84
23–16	Starting address bank 6	0x00	Starting address for bank 6	
15–8	Starting address bank 5	0x00	Starting address for bank 5	
7–0	Starting address bank 4	0x00	Starting address for bank 4	

Figure 4-9, Figure 4-10, and Table 4-25 depict the extended memory starting address register 1 and 2 bit settings.

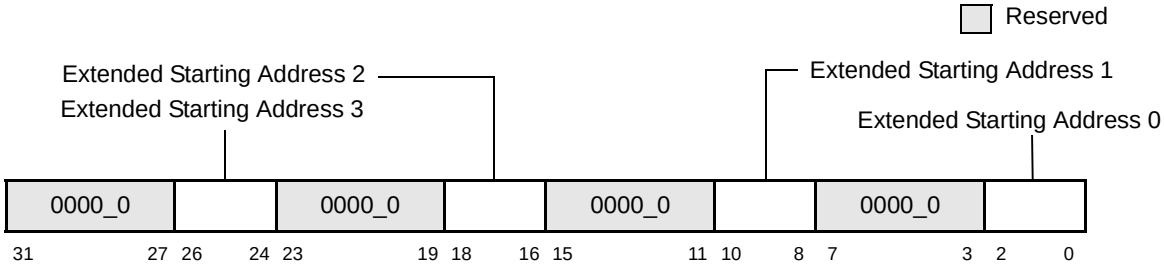


Figure 4-9. Extended Memory Starting Address Register 1—0x88.

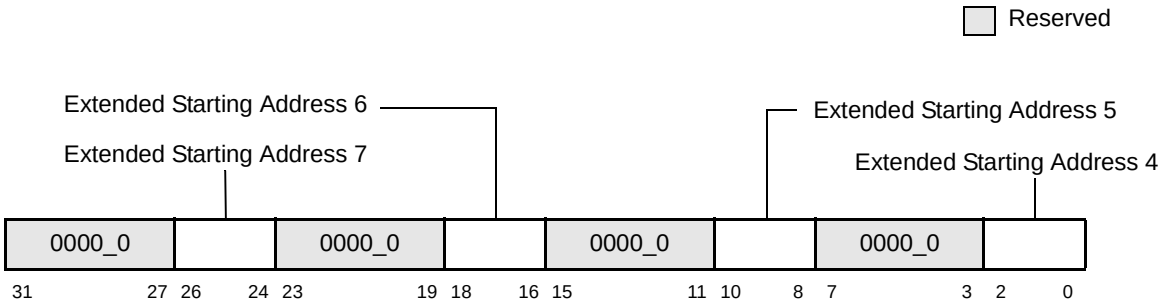


Figure 4-10. Extended Memory Starting Address Register 2—0x8C

Table 4-25. Bit Settings for Extended Memory Starting Address Registers 1 and 2

Bits	Name	Reset Value	Description	Byte Address
31–27	—	All 0s	Reserved	0x88
26–24	Extended starting address 3	All 0s	Extended starting address for bank 3	
23–19	—	All 0s	Reserved	
18–16	Extended starting address 2	All 0s	Extended starting address for bank 2	
15–11	—	All 0s	Reserved	
10–8	Extended starting address 1	All 0s	Extended starting address for bank 1	
7–3	—	All 0s	Reserved	
2–0	Extended starting address 0	All 0s	Extended starting address for bank 0	
31–27	—	All 0s	Reserved	0x8C
26–24	Extended starting address 7	All 0s	Extended starting address for bank 7	
23–19	—	All 0s	Reserved	
18–16	Extended starting address 6	All 0s	Extended starting address for bank 6	
15–11	—	All 0s	Reserved	
10–8	Extended starting address 5	All 0s	Extended starting address for bank 5	
7–3	—	All 0s	Reserved	
2–0	Extended starting address 4	All 0s	Extended starting address for bank 4	

Figure 4-11, Figure 4-12, and Table 4-26 depict the memory ending address register 1 and 2 bit settings.

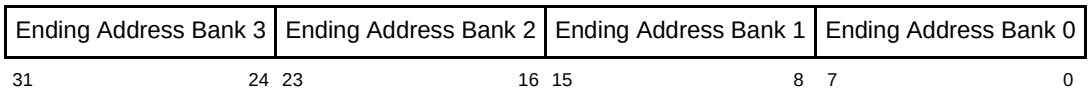


Figure 4-11. Memory Ending Address Register 1—0x90

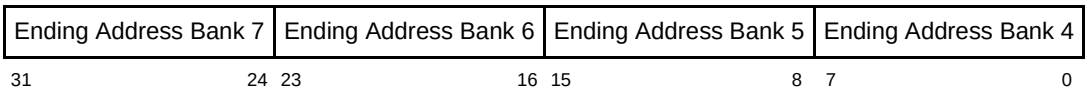


Figure 4-12. Memory Ending Address Register 2—0x94

Table 4-26. Bit Settings for Memory Ending Address Registers 1 and 2

Bits	Name	Reset Value	Description	Byte Address
31–24	Ending address bank 3	0x00	Ending address for bank 3	0x90
23–16	Ending address bank 2	0x00	Ending address for bank 2	
15–8	Ending address bank 1	0x00	Ending address for bank 1	
7–0	Ending address bank 0	0x00	Ending address for bank 0	
31–24	Ending address bank 7	0x00	Ending address for bank 7	0x94
23–16	Ending address bank 6	0x00	Ending address for bank 6	
15–8	Ending address bank 5	0x00	Ending address for bank 5	
7–0	Ending address bank 4	0x00	Ending address for bank 4	

Figure 4-13, Figure 4-14, and Table 4-27 depict the extended memory ending address register 1 and 2 bit settings.

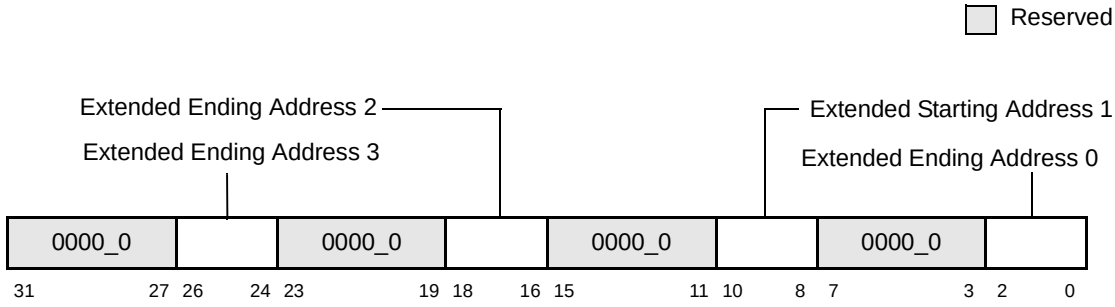


Figure 4-13. Extended Memory Ending Address Register 1—0x98

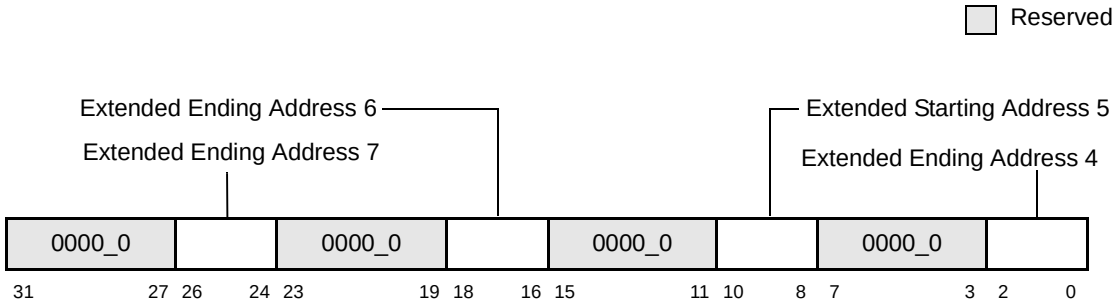


Figure 4-14. Extended Memory Ending Address Register 2—0x9C

Table 4-27. Bit Settings for Extended Memory Ending Address Registers 1 and 2

Bits	Name	Reset Value	Description	Byte Address
31–27	—	All 0s	Reserved	0x98
26–24	Extended ending address 3	All 0s	Extended ending address for bank 3	
23–19	—	All 0s	Reserved	
18–16	Extended ending address 2	All 0s	Extended ending address for bank 2	
15–11	—	All 0s	Reserved	
10–8	Extended ending address 1	All 0s	Extended ending address for bank 1	
7–3	—	All 0s	Reserved	
2–0	Extended ending address 0	All 0s	Extended ending address for bank 0	
31–27	—	All 0s	Reserved	0x9C
26–24	Extended ending address 7	All 0s	Extended ending address for bank 7	
23–19	—	All 0s	Reserved	
18–16	Extended ending address 6	All 0s	Extended ending address for bank 6	
15–11	—	All 0s	Reserved	
10–8	Extended ending address 5	All 0s	Extended ending address for bank 5	
7–3	—	All 0s	Reserved	
2–0	Extended ending address 4	All 0s	Extended ending address for bank 4	

4.6.2 Memory Bank Enable Register—0xA0

Individual banks of memory are enabled or disabled by using the 1-byte memory bank enable register, shown in Figure 4-15 and Table 4-28. Each enabled memory bank corresponds to a physical bank of memory enabled by one of the $\overline{\text{CS}}$[0:7] signals for SDRAM. If a bank is enabled, the ending address of that bank must be greater than or equal to its starting address. If a bank is disabled, no memory transactions access that bank regardless of its starting and ending addresses.

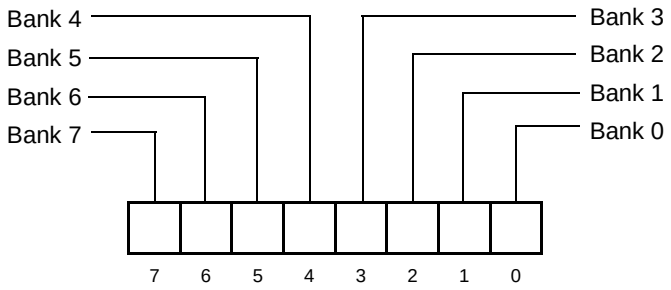


Figure 4-15. Memory Bank Enable Register—0xA0

Table 4-28. Bit Settings for Memory Bank Enable Register—0xA0

Bits	Name	Reset Value	Description
7	Bank 7	0	Bank 7 0 Disabled 1 Enabled
6	Bank 6	0	Bank 6 0 Disabled 1 Enabled
5	Bank 5	0	Bank 5 0 Disabled 1 Enabled
4	Bank 4	0	Bank 4 0 Disabled 1 Enabled
3	Bank 3	0	Bank 3 0 Disabled 1 Enabled
2	Bank 2	0	Bank 2 0 Disabled 1 Enabled
1	Bank 1	0	Bank 1 0 Disabled 1 Enabled
0	Bank 0	0	Bank 0 0 Disabled 1 Enabled

4.6.3 Memory Page Mode Register—0xA3

The 1-byte memory page mode register, shown in Figure 4-16 and Table 4-29, contains the PGMAX parameter which controls how long the MPC8245 retains the currently accessed page (row) in memory. See Section 6.2.7, “SDRAM Page Mode,” for more information.

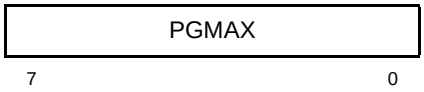


Figure 4-16. Memory Page Mode Register—0xA3

Table 4-29. Bit Settings for Memory Page Mode Register—0xA3

Bits	Name	Reset Value	Description
7–0	PGMAX	All 0s	For SDRAM configurations, the value of PGMAX multiplied by 64 determines the activate to precharge interval (sometimes called row active time or t_{RAS}) for retained page mode. When programmed to 0x00, page mode is disabled.

4.7 Processor Interface Configuration Registers

The processor interface configuration registers (PICRs) control the programmable parameters of the peripheral bus interface to the processor core. There are two 32-bit PICRs—PICR1 and PICR2. Figure 4-17 shows the bits of PICR1.

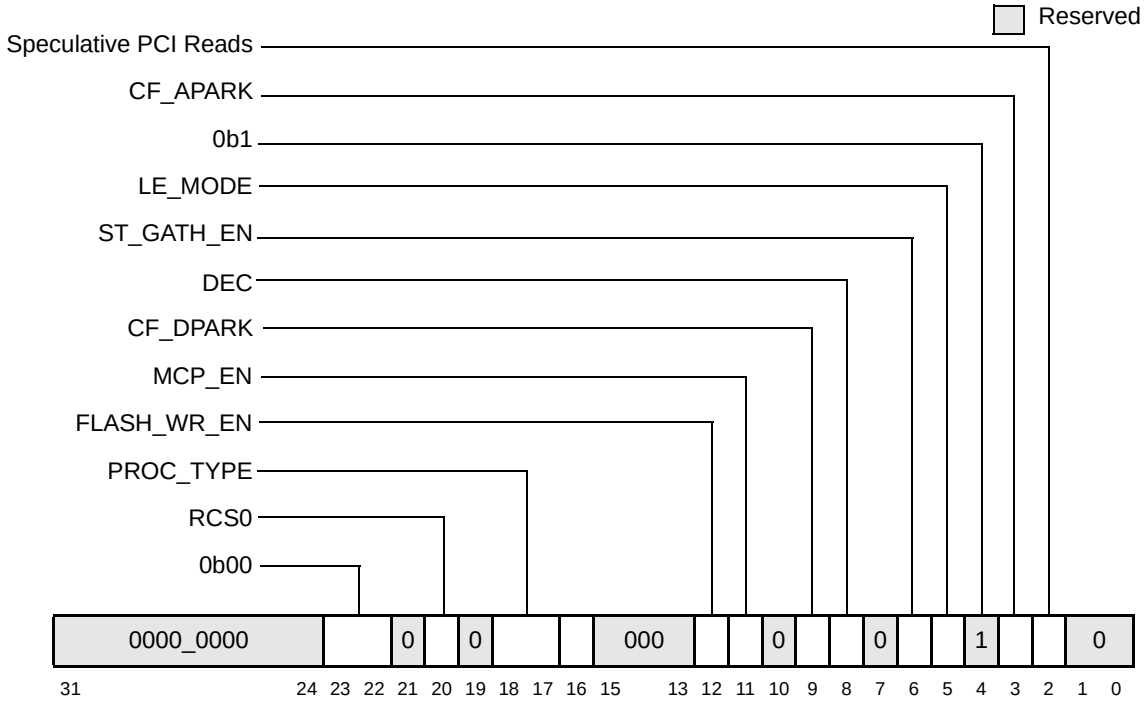


Figure 4-17. Processor Interface Configuration Register 1 (PICR1)—0xA8

Table 4-30 describes the PICR1 bit settings.

Table 4-30. Bit Settings for PICR1—0xA8

Bits	Name	Reset Value	Description
31–24	—	All 0s	Reserved
23–22	—	00	00 Must be cleared to 0b00
21	—	0	Reserved
20	RCS0	x [1]	ROM location (read/write). This bit indicates the state of the ROM location ($\overline{RCS0}$) configuration signal during reset. 0 ROM is located on PCI bus. 1 ROM is located on processor/memory data bus.
19	—	0	Reserved
18–17	PROC_TYPE	10	Processor type. These bits identify the type of processor used in the system and determine the $\overline{QREQ}$, $\overline{QACK}$ protocol used for power management. 10 MPC603e

Table 4-30. Bit Settings for PICR1—0xA8 (continued)

Bits	Name	Reset Value	Description
16–13 addr <a9>	—	00	Reserved
12	FLASH_WR_EN	0	Flash write enable. This bit controls whether the MPC8245 allows write operations to Flash ROM. Note that if writes to Flash are enabled (with read-only devices in the banks), and a write transaction occurs, then bus contention may occur because the write data is driven on the data bus, and the read-only device starts driving the data bus. This can be avoided by disabling write capability to the Flash/ROM address space through the FLASH_WR_EN and/or FLASH_WR_LOCKOUT_EN configuration bits or by connecting the $\overline{\text{FOE}}$ signal to the output enable of the read-only device. 0 Flash write is disabled. 1 Flash write is enabled.
11	MCP_EN	0	Machine check enable. This bit controls whether the MPC8245 asserts $\overline{\text{MCP}}$ (and takes the machine check exception) upon detecting an error. See Chapter 14, “Error Handling,” for more information. 0 Machine check is disabled. 1 Machine check is enabled.
10	—	0	Reserved
9	CF_DPARK	0	Data bus park. This bit indicates whether the processor core is parked on the peripheral logic data bus. 0 Processor core is not parked on the data bus. 1 Processor core is parked on the data bus. It is recommended that software set this bit.
8	DEC	0	This bit can be used to enable the time base and decrementor of the processor core. In extended addressing mode, the TBEN signal functions as SDMA13. This bit can be used by software to enable the time base and decrementor in the processor core. 0 Disable processor core decrementer in extended addressing mode 1 Enable processor core decrementer in extended addressing mode
7	NO_BUS_ WIDTH_CHECK	0	This bit controls whether the MPC8245 checks the data path size of processor writes to local base ROM space. See14.3.1.2, “Flash Write Error,” for more information. 0 Bus width check is enabled. An attempt to write to Flash with a transfer size other than the base ROM data bus size (for example, a 32-bit write to 8-bit Flash) may cause a Flash write error. 1 Bus width check is disabled. An attempt to write to Flash with a transfer size other than the base ROM data bus size does not cause a Flash write error.
6	ST_GATH_EN	0	This bit enables store gathering of writes from the processor to PCI memory space. See Chapter 13, “Central Control Unit,” for more information. 0 Store gathering is disabled. 1 Store gathering is enabled.
5	LE_MODE	0	This bit controls the endian mode of the MPC8245. See Appendix A, “Bit and Byte Ordering,” for more information. 0 Big-endian mode 1 Little-endian mode

Table 4-30. Bit Settings for PICR1—0xA8 (continued)

Bits	Name	Reset Value	Description
4	—	1	Reserved and must be set
3	CF_APARK	0	This bit indicates whether the processor address bus is parked. 0 Indicates that the processor core is not parked on the peripheral logic address bus 1 Indicates that the processor core is parked on the peripheral logic address bus
2	Speculative PCI Reads	0	This bit controls speculative PCI reads from memory. Note that the peripheral logic block performs a speculative read in response to a PCI read-multiple command, even if this bit is cleared. See Chapter 13, “Central Control Unit,” for more information. 0 Indicates that speculative reads are disabled. 1 Indicates that speculative reads are enabled.
1–0	—	00	Reserved

1 Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

Figure 4-18 shows the bits of the PICR2.

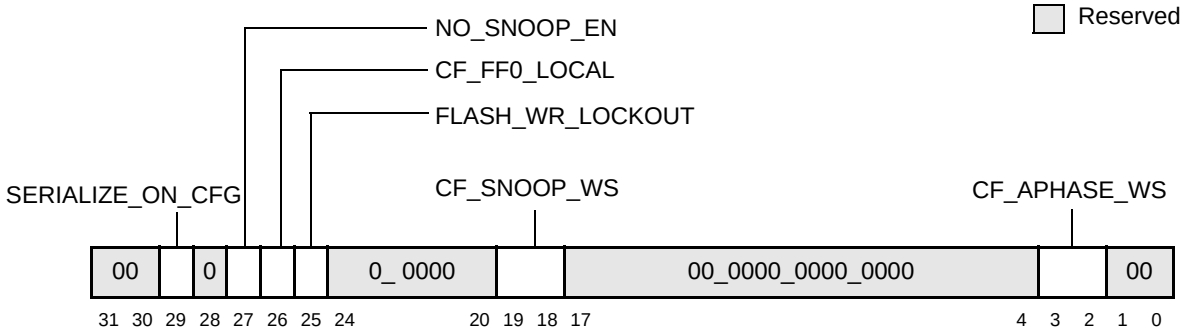


Figure 4-18. Processor Interface Configuration Register 2 (PICR2)—0xAC

Table 4-31 describes the bit settings for PICR2.

Table 4-31. Bit Settings for PICR2—0xAC

Bits	Name	Reset Value	Description
31–30	—	00	Reserved
29	SERIALIZE_ON_CFG	0	This bit controls whether the MPC8245 serializes configuration writes to PCI devices from the processor. Note that the sense of this bit is the opposite of that on the MPC8240. 0 Configuration writes to PCI devices from the processor do not cause serialization. The internal buffers are not flushed. 1 Configuration writes to PCI devices from the processor cause the MPC8245 to serialize and flush the internal buffers.
28	—	0	Reserved

Table 4-31. Bit Settings for PICR2—0xAC (continued)

Bits	Name	Reset Value	Description
27	NO_SNOOP_EN	0	This bit controls whether the MPC8245 generates snoop transactions on the peripheral logic bus for PCI-to-system memory transactions. This is provided as a performance enhancement for systems that do not need to maintain coherency on system memory accesses by PCI. 0 Snooping is enabled. 1 Snooping is disabled.
26	CF_FF0_LOCAL	0	ROM remapping enable. This bit allows the lower 8 Mbytes of the ROM/Flash address range to be remapped from the PCI bus to the processor/memory bus. Note that this bit is meaningful only if the ROM location parameter indicates that ROM is located on PCI bus (PICR1[RCS0] = 0). 0 ROM/Flash remapping disabled. The lower 8 Mbytes of the ROM/Flash address space are not remapped. All ROM/Flash accesses are directed to the PCI bus. 1 ROM/Flash remapping enabled. The lower 8 Mbytes of the ROM/Flash address space are remapped to the processor/memory bus. ROM/Flash accesses in the range 0xFF00_0000–0xFF7F_FFFF are directed to the processor/memory bus. ROM/Flash accesses in the range 0xFF80_0000–0xFFFF_FFFF are directed to the PCI bus.
25	FLASH_WR_LOCKOUT	0	Flash write lockout. This bit, once set, prevents writing to Flash. Once set, this bit can only be cleared by a hard reset. 0 Write operations to Flash are enabled, provided FLASH_WR_EN = 1. 1 Write operations to Flash are disabled until the MPC8245 is reset.
24–20	—	0_0000	Reserved
19–18	CF_SNOOP_WS	11	Snoop wait states. These bits control the minimum number of wait states for the address phase in a snoop cycle. 00 0 wait states (2-clock address phase); can be used for all other CPU to memory clock ratios 01 1 wait state (3-clock address phase); should be used when 1:1 or 3:2 CPU to memory clock ratios are used 10 2 wait states (4-clock address phase); not recommended 11 3 wait states (5-clock address phase); default, but not recommended
17–4	—	All 0s	Reserved
3–2	CF_APHASE_WS	11	Internal Address phase wait states. These bits control the minimum number of address phase wait states (in clock cycles) for processor-initiated operations. For optimal performance, this parameter should be changed to 0b00 00 0 wait states 01 1 wait state; not recommended 10 2 wait states; not recommended 11 3 wait states; default, but not recommended
1–0	—	00	Reserved

4.8 Error Handling Registers

Chapter 14, “Error Handling,” describes specific error conditions and how the MPC8245 responds to them. The registers at offsets 0xB8, 0xB9, and 0xC0 through 0xCB control the error handling and reporting for the MPC8245. The following sections provide descriptions of these registers.

4.8.1 ECC Single-Bit Error Registers

The ECC single-bit error registers are two 8-bit registers used to control the reporting of ECC single-bit errors. See Chapter 14, “Error Handling,” for more information. The ECC single-bit error counter, shown in Figure 4-19, maintains a count of the number of single-bit errors that have been detected. It is a read/write register that is cleared to 0x00 whenever any data is written to it.

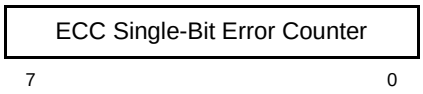


Figure 4-19. ECC Single-Bit Error Counter Register—0xB8

Table 4-32 describes the bits of the ECC single-bit error counter.

Table 4-32. Bit Settings for ECC Single-Bit Error Counter Register—0xB8

Bits	Name	Reset Value	Description
7–0	ECC single-bit error counter	All 0s	These bits maintain a count of the number of ECC single-bit errors that have been detected and corrected. If this value equals the value contained in the ECC single-bit error trigger register, then an error is reported (provided ErrEnR1[2] = 1).

The ECC single-bit error trigger, shown in Figure 4-20, provides a threshold value that, when equal to the single-bit error count, triggers the MPC8245 error reporting logic.

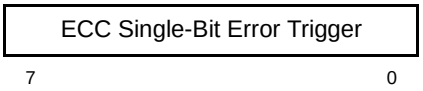


Figure 4-20. ECC Single-Bit Error Trigger Register—0xB9

Table 4-33 describes the bits of the ECC single-bit error trigger.

Table 4-33. Bit Settings for ECC Single-Bit Error Trigger Register—0xB9

Bits	Name	Reset Value	Description
7–0	ECC single-bit error trigger	All 0s	These bits provide the threshold value for the number of ECC single-bit errors that are detected before reporting an error condition. If the value of the single bit error counter register equals the value of this register, then an error is reported (provided ErrEnR1[2] = 1). If this register = 0x00, then no single bit error is ever generated.

4.8.2 Error Enabling and Detection Registers

The error enabling registers 1 and 2 (ErrEnR1 and ErrEnR2), shown in Figure 4-21 and Figure 4-24, control whether the MPC8245 recognizes and reports specific error conditions. Table 4-34 describes the bits of ErrEnR1, and Table 4-37 describes the bits of ErrEnR2.

The error detection registers 1 and 2 (ErrDR1 and ErrDR2), shown in Figure 4-22 and Figure 4-25, contain error flags that report when the MPC8245 detects a specific error condition.

The error detection registers are bit-reset type registers. That is, reading from these registers occurs normally; however, write operations are different in that bits (error flags) can be cleared but not set. A bit is cleared whenever the register is written, and the data in the corresponding bit location is a 1. For example, to clear bit 6 and not affect other bits in the register, write 0b0100_0000 to the register. When the MPC8245 detects an error, the appropriate error flag is set. Subsequent errors set the appropriate error flags in the error detection registers, but the bus error status and error address are not recorded until the previous error flags are cleared.

The processor bus error status register (BESR) is also described in this section, as its address offset is 0xC3, which falls in between the ErrDR1 and ErrEnR2 in the memory map. This register saves the value of the TT[0:4] and TSIZ[0:2] when a processor-initiated bus error is detected.

The PCI bus error status register and processor/PCI error address register are described in Figure 4-26 and Figure 4-27.

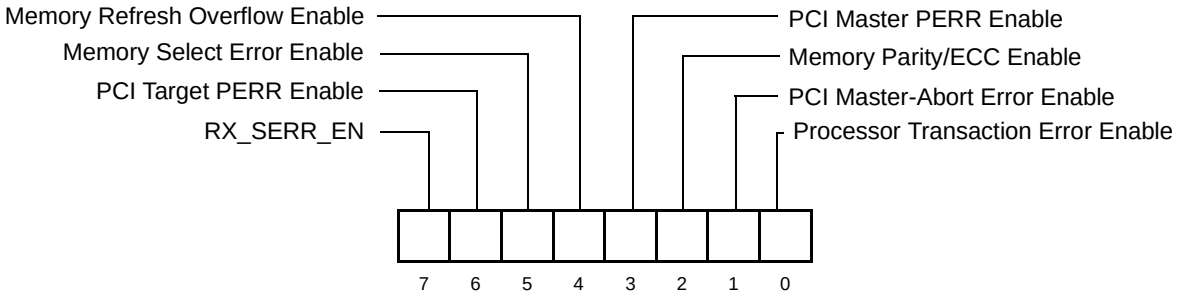


Figure 4-21. Error Enabling Register 1 (ErrEnR1)—0xC0

Table 4-34. Bit Settings for Error Enabling Register 1 (ErrEnR1)—0xC0

Bits	Name	Reset Value	Description
7	RX_SERR_EN	0	This bit enables the reporting of $\overline{\text{SERR}}$ assertions that occur on the PCI bus two clock cycles after the address phase of transactions where the MPC8245 is the initiator. 0 Received PCI $\overline{\text{SERR}}$ disabled 1 Received PCI $\overline{\text{SERR}}$ enabled
6	PCI target $\overline{\text{PERR}}$ enable	0	This bit enables the reporting of data parity errors on the PCI bus for transactions involving the MPC8245 as a target. 0 Target $\overline{\text{PERR}}$ disabled 1 Target $\overline{\text{PERR}}$ enabled
5	Memory select error enable	0	This bit enables the reporting of memory select errors that occur on (attempted) accesses to system memory. 0 Memory select error disabled 1 Memory select error enabled
4	Memory refresh overflow enable	0	This bit enables the reporting of memory refresh overflow errors. 0 Memory refresh overflow disabled 1 Memory refresh overflow enabled
3	PCI master $\overline{\text{PERR}}$ enable	0	This bit enables the reporting of data parity errors on the PCI bus for transactions involving the MPC8245 as a master. 0 Master $\overline{\text{PERR}}$ disabled 1 Master $\overline{\text{PERR}}$ enabled
2	Memory parity/ECC enable	0	This bit enables the reporting of system memory read parity errors that occur on accesses to system memory or those that equal the ECC single-bit error threshold. [For SDRAM with in-line ECC/parity, this is the memory write parity enable bit.] 0 Memory read parity/ECC single-bit threshold disabled 1 Memory read parity/ECC single-bit threshold enabled
1	PCI master-abort error enable	0	This bit enables the reporting of master-abort errors that occur on the PCI bus for transactions involving the MPC8245 as a master. 0 PCI master-abort error disabled 1 PCI master-abort error enabled
0	Processor transaction error enable	1	This bit enables the reporting of processor transaction errors. 0 Processor transaction error disabled 1 Processor transaction bus error enabled

Figure 4-22 shows the bits of error detection register 1.

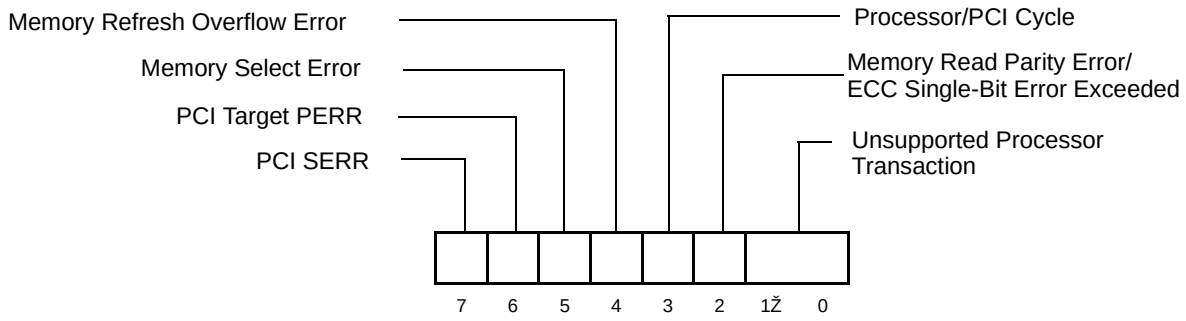


Figure 4-22. Error Detection Register 1 (ErrDR1)—0xC1

Table 4-35 describes the bits of error detection register 1.

Table 4-35. Bit Settings for Error Detection Register 1 (ErrDR1)—0xC1

Bits	Name	Reset Value	Description
7	PCI $\overline{\text{SERR}}$	0	MPC8245, as a PCI initiator, detected $\overline{\text{SERR}}$ asserted by an external PCI agent two clock cycles after the address phase. 0 $\overline{\text{SERR}}$ not detected 1 $\overline{\text{SERR}}$ detected
6	PCI target $\overline{\text{PERR}}$	0	PCI target $\overline{\text{PERR}}$ 0 The MPC8245, as a PCI target, has not detected a data parity error 1 The MPC8245, as a PCI target, detected a data parity error
5	Memory select error	0	Memory select error 0 No error detected 1 Memory select error detected
4	Memory refresh overflow error	0	Memory refresh overflow error 0 No error detected 1 Memory refresh overflow has occurred
3	Processor/PCI cycle	0	Processor/PCI cycle 0 Error occurred on a processor-initiated cycle. 1 Error occurred on a PCI-initiated cycle.
2	Memory read parity error/ECC single-bit error trigger exceeded	0	Memory read parity error/ECC single-bit error trigger exceeded 0 No error detected 1 Parity error detected or ECC single-bit error trigger exceeded
1–0	Unsupported processor transaction	00	Unsupported processor transaction 00 No error detected 01 Unsupported transfer attributes. Refer to Chapter 14, “Error Handling,” for more details. 10 Reserved 11 Reserved

The processor bus error status register (BESR) latches the state of the internal processor address attributes when an internal bus error is detected. This information then can be used by error handling software. Figure 4-23 shows the bits of the processor bus error status register, and Table 4-36 provides a detailed description of the bit settings.

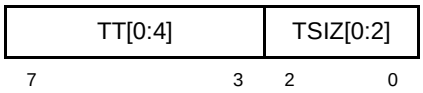


Figure 4-23. Internal Processor Bus Error Status Register—0xC3

Table 4-36. Bit Settings for Internal Processor Bus Error Status Register—0xC3

Bits	Name	Reset Value	Description
7–3	TT[0:4]	0000_0	These bits maintain a copy of TT[0:4]. When a processor bus error is detected, these bits are latched until all error flags are cleared.
2–0	TSIZ[0:2]	000	These bits maintain a copy of TSIZ[0:2]. When a processor bus error is detected, these bits are latched until all error flags are cleared.

Figure 4-24 shows the enable bits for ErrEnR2.

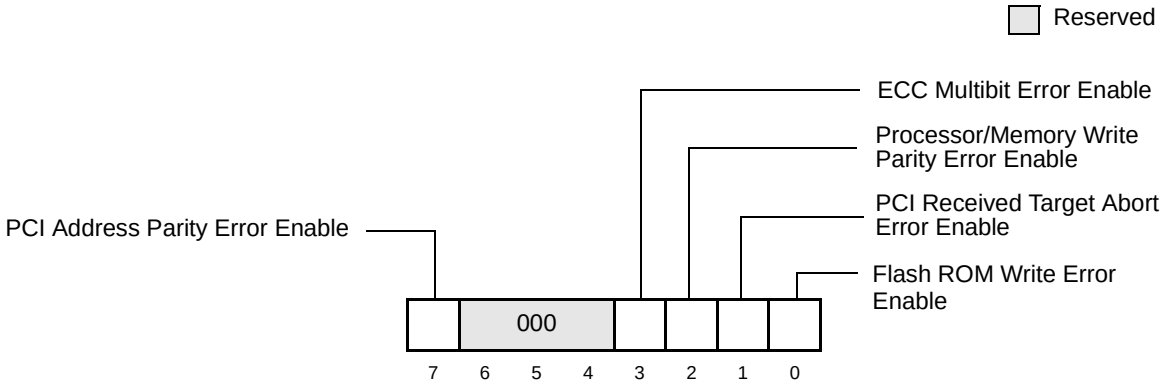


Figure 4-24. Error Enabling Register 2 (ErrEnR2)—0xC4

Table 4-37 describes the bits for ErrEnR2.

Table 4-37. Bit Settings for Error Enabling Register 2 (ErrEnR2)—0xC4

Bits	Name	Reset Value	Description
7	PCI address parity error enable	0	This bit controls whether the MPC8245 asserts $\overline{\text{MCP}}$ (provided $\overline{\text{MCP}}$ is enabled) if an address parity error is detected by the MPC8245 acting as a PCI target. 0 PCI address parity errors disabled 1 PCI address parity errors enabled
6–4	—	000	Reserved
3	ECC multi-bit error enable	0	This bit enables the detection of ECC multibit errors. 0 ECC multi-bit error detection disabled 1 ECC multi-bit error detection enabled

Table 4-37. Bit Settings for Error Enabling Register 2 (ErrEnR2)—0xC4 (continued)

Bits	Name	Reset Value	Description
2	Processor memory write parity error enable	0	This bit enables the detection of processor memory write parity errors. (note: applies only for SDRAM with in-line parity checking). 0 Processor memory write error detection disabled 1 Processor memory write error detection enabled
1	PCI received target abort error enable	0	This bit enables the detection of target abort errors received by the PCI interface. 0 Target abort error detection disabled 1 Target abort error detection enabled
0	Flash ROM write error enable	0	This bit controls whether the MPC8245 detects attempts to write to Flash when either PICR1[FLASH_WR_EN] = 0 or PICR2[FLASH_WR_LOCKOUT] = 0. 0 Disabled 1 Enabled

Figure 4-25 shows the bits for error detection register 2.

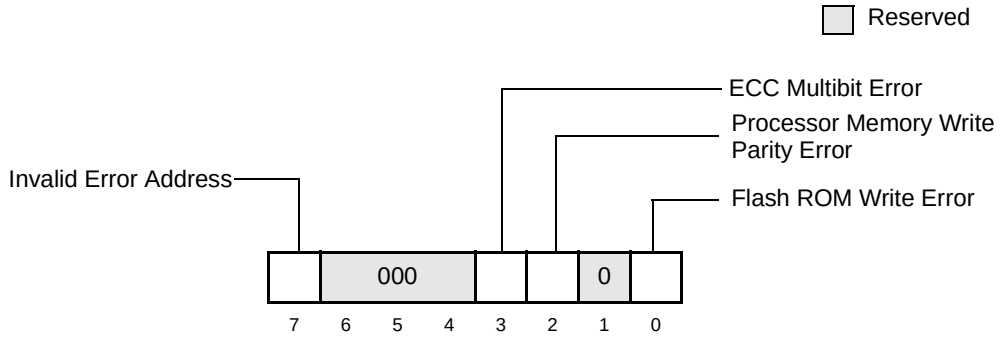


Figure 4-25. Error Detection Register 2 (ErrDR2)—0xC5

Table 4-38 describes the bits of error detection register 2.

Table 4-38. Bit Settings for Error Detection Register 2 (ErrDR2)—0xC5

Bits	Name	Reset Value	Description
7	Invalid error address	0	This bit indicates whether the address stored in the processor/PCI error address register is valid. 0 The address in the error address register is valid. 1 The address in the error address register is not valid.
6–4	—	000	Reserved
3	ECC multi bit error	0	ECC multibit error 0 No ECC multi bit error detected 1 ECC multibit error detected

Table 4-38. Bit Settings for Error Detection Register 2 (ErrDR2)—0xC5 (continued)

Bits	Name	Reset Value	Description
2	Processor memory write parity error	0	Processor memory write parity error (SDRAM with in-line parity checking only). 0 No error detected 1 Processor memory write parity error detected
1	—	0	Reserved
0	Flash ROM write error	0	Flash ROM write error 0 No error detected 1 The MPC8245 detected a write to Flash ROM when writes to ROM/Flash are disabled.

The PCI bus error status register latches the state of the PCI $\overline{C/BE}$[3:0] signals when an error is detected on the PCI bus, as defined in Section 14.3.3, “PCI Interface Errors.” Figure 4-26 shows the PCI bus error status register.

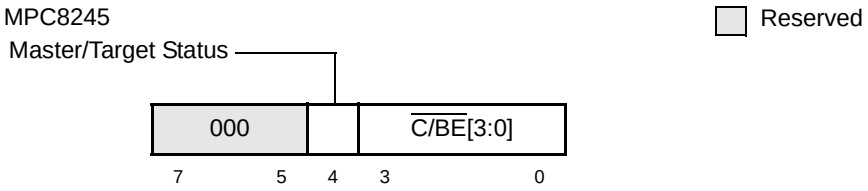


Figure 4-26. PCI Bus Error Status Register—0xC7

Table 4-39 describes the bits of the PCI bus error status register.

Table 4-39. Bit Settings for PCI Bus Error Status Register—0xC7

Bits	Name	Reset Value	Description
7–5	—	000	Reserved
4	MPC8245 master/target status	0	MPC8245 master/target status 0 MPC8245 is the PCI master. 1 MPC8245 is the PCI target.
3–0	$\overline{C/BE}$[3:0]	0000	These bits maintain a copy of $\overline{C/BE}$[3:0]. When a PCI bus error is detected, these bits are latched until all error flags are cleared.

The processor/PCI error address register maintains address bits for either the processor bus or the PCI bus transaction that generated an error as shown in Figure 4-27.

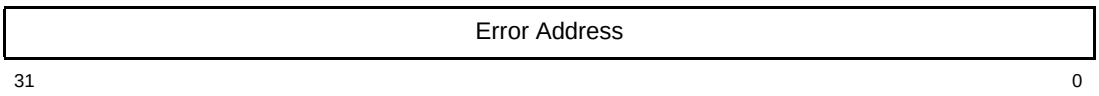


Figure 4-27. Processor/PCI Error Address Register—0xC8

Table 4-40 describes the bits of processor/PCI error address register.

Table 4-40. Bit Settings for Processor/PCI Error Address Register—0xC8

Bits	Name	Reset Value	Description
31–24	Error address	0x00	A[24:31] or AD[7:0]—Dependent on whether the error is a processor bus error or a PCI bus error. When an error is detected, these bits are latched until all error flags are cleared.
23–16		0x00	A[16:23] or AD[15:8]—(Dependent on whether the error is a processor bus error or a PCI bus error. When an error is detected, these bits are latched until all error flags are cleared.
15–8		0x00	A[8:15] or AD[23:16]—Dependent on whether the error is a processor bus error or a PCI bus error. When an error is detected, these bits are latched until all error flags are cleared.
7–0		0x00	A[0:7] or AD[31:24]—Dependent on whether the error is a processor bus error or a PCI bus error. When an error is detected, these bits are latched until all error flags are cleared.

4.9 Extended ROM Configuration Registers—0xD0, 0xD4, 0xD8, 0xDC

The ERCRs control the programmable features of the extended ROM.

Figure 4-28 shows the bits for ERCR1 and ERCR2.

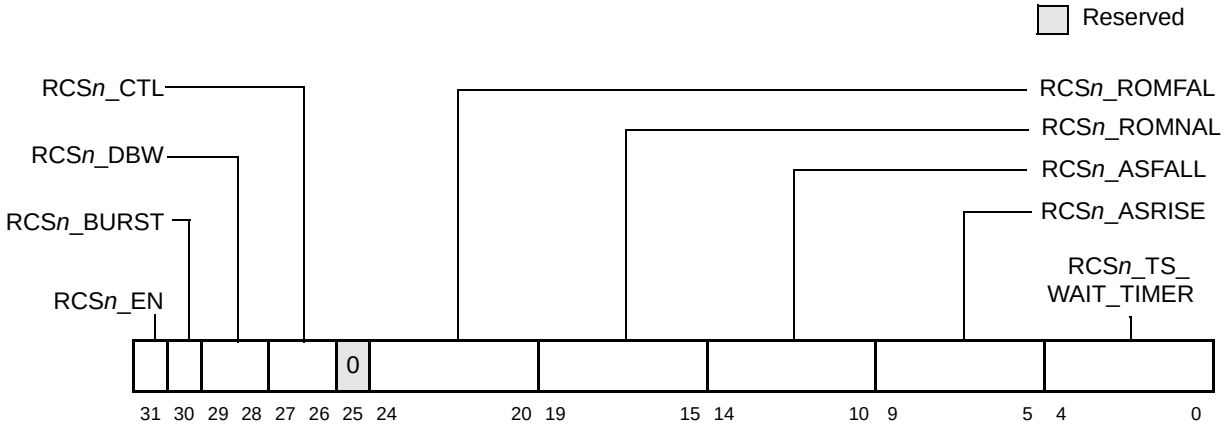


Figure 4-28. ERCR1 and ERCR2—0xD0, 0xD4

Table 4-41 describes the bit settings of ERCR1.

Table 4-41. Extended ROM Configuration Register 1—0xD0

Bits	Name	Reset Value	Description
msb 31	RCS2_EN	1	ROM chip-select 2 enable 0 RCS2 disabled 1 RCS2 enabled
30	RCS2_BURST	0	Burst mode ROM chip-select 2 timing enable 0 Indicates standard (nonburst) ROM access timing 1 Indicates burst-mode ROM access timing. When burst mode is enabled, ROM reads use RCS2_ROMNAL for burst beats.
29–28	RCS2_DBW	11	These bits control the of the data bus width for $\overline{\text{RCS2}}$. 00 8-bit data path with gathering 01 16-bit data path with gathering 10 32-bit data path with gathering. Gathering occurs if DBUS0 = 1. 11 wide data path; 64-bit if DBUS0 = 1, 32-bit if DBUS0 = 0
27–26	RCS2_CTL	01	This field determines the type of device and timing used for RCS2. 00 Independent $\overline{\text{RCS2}}$ ROM/FLASH timing mode—$\overline{\text{RCS2}}$ uses the timing controls (RCS2_ROMFAL, RCS2_ROMNAL, RCS2_TS_WAIT_TIMER, RCS2_ASFALL, and RCS2_ASRISE) set in this register. 01 Base ROM/FLASH timing mode—$\overline{\text{RCS2}}$ uses the same timing controls (ROMFAL, ROMNAL, TS_WAIT_TIMER, ASFAL, and ASRISE) as the base ROM interface specified in the MCCRs. 10 RCS2 Port X strobe mode—See Section 6.3.5, “Port X Interface,” for more information. Note that flash recovery time is disabled in this mode. Also note that the relevant time parameters for this mode are RCS2_ROMFAL, RCS2_TS_WAIT_TIMER, RCS2_ASRISE, and RCS2_ASFALL. 11 RCS2 Port X handshake mode—See Section 6.3.5, “Port X Interface,” for more information.Note that flash recovery time is disabled in this mode. Also note that the relevant time parameters for this mode are RCS2_ROMFAL, RCS2_TS_WAIT_TIMER, RCS2_ASRISE, and RCS2_ASFALL.
25	—	0	Reserved
24–20	RCS2_ROMFAL	All 1s	For nonburst ROM and Flash reads, RCS2_ROMFAL controls the access time. For burst-mode ROMs, RCS2_ROMFAL controls the first access time. The maximum value is 0b11111 (31). For the 64-bit and 32-bit configurations, the actual cycle count is three cycles more than the binary value of RCS2_ROMFAL. For the 8-bit configuration, the actual cycle count is two cycles more than the binary value of RCS2_ROMFAL. For Flash writes, RCS2_ROMFAL measures the write pulse low time. The maximum value is 0b11111 (31). The actual cycle count is two cycles more than the binary value of RCS2_ROMFAL. Note that this timing is only in effect if ERCR1[RCS2_CTL] $\neq$ 01.
19–15	RCS2_ROMNAL	All 1s	For burst-mode ROM and Flash reads, RCS2_ROMNAL controls the next access time. The maximum value is 0b11111 (31). The actual cycle count is three cycles more than the binary value of RCS2_ROMNAL. For Flash writes, RCS2_ROMNAL measures the write pulse recovery (high) time. The maximum value is 0b11111 (31) The actual cycle count is four cycles more than the binary value of RCS2_ROMNAL. Note that this timing is only in effect if ERCR1[RCS2_CTL] = 00.

Table 4-41. Extended ROM Configuration Register 1—0xD0 (continued)

Bits	Name	Reset Value	Description
14–10	RCS2_ASFALL	All 0s	RCS2 $\overline{\text{AS}}$ fall time. These bits control the falling edge timing of the $\overline{\text{AS}}$ signal relative to the falling edge of $\overline{\text{RCS2}}$ for the Port X interface. See Section 6.3.5, “Port X Interface,” for more information. 00000 0 clocks ($\overline{\text{AS}}$ asserted coincident with the chip select) 00001 1 clock 00010 2 clocks 00011 3 clocks ... 11111 31 clocks
9–5	RCS2_ASRISE	All 0s	RCS2 $\overline{\text{AS}}$ rise time. These bits control the rising edge timing of the $\overline{\text{AS}}$ signal relative to the falling edge of $\overline{\text{RCS2}}$ for the Port X interface. See Section 6.3.5, “Port X Interface,” for more information. 00000 Disables $\overline{\text{AS}}$ signal generation 00001 1 clock 00010 2 clocks 00011 3 clocks ... 11111 31 clocks

Table 4-41. Extended ROM Configuration Register 1—0xD0 (continued)

<table>
<tr><th>Bits</th><th>Name</th><th>Reset Value</th><th>Description</th></tr>
<tr><td>4–0</td><td>RCS2_TS_ WAIT_TIMER</td><td>All 0s</td><td>RCS2 Transaction start wait states timer. The minimum time allowed for ROM/Flash/Port X devices to enter high impedance is 2 memory system clocks. RCS2_TS_WAIT_TIMER[0–2] adds wait states before the subsequent transaction starts in order to account for longer disable times of a ROM/Flash/Port X device. This delay is enforced after all ROM and Flash accesses to ROM bank 2, delaying the next memory access from starting (for example, SDRAM after ROM access, SDRAM after Flash access, ROM after Flash access).
<table>
<tr><th rowspan="2">bits</th><th colspan="4">Wait States for ROM High Impedance</th></tr>
<tr><th>Reads with wide data path (32 or 64-bit)</th><th>Reads with gather data path in registered buffer mode (8, 16, 32-bit)</th><th>All Flash writes[1,2] and reads with gather data path in inline buffer mode (8, 16, 32,-bit)</th><th>All Port X writes [3]</th></tr>
<tr><td>00000</td><td>2 clocks</td><td>5 clocks</td><td>6 clocks</td><td>3 clocks</td></tr>
<tr><td>00001</td><td>2 clocks</td><td>5 clocks</td><td>6 clocks</td><td>3 clocks</td></tr>
<tr><td>00010</td><td>3 clocks</td><td>5 clocks</td><td>6 clocks</td><td>3 clocks</td></tr>
<tr><td>00011</td><td>4 clocks</td><td>5 clocks</td><td>6 clocks</td><td>4 clocks</td></tr>
<tr><td>00100</td><td>5 clocks</td><td>5 clocks</td><td>6 clocks</td><td>5 clocks</td></tr>
<tr><td>00101</td><td>6 clocks</td><td>6 clocks</td><td>6 clocks</td><td>6 clocks</td></tr>
<tr><td>00110</td><td>7 clocks</td><td>7 clocks</td><td>7 clocks</td><td>7 clocks</td></tr>
<tr><td>00111</td><td>8 clocks</td><td>8 clocks</td><td>8 clocks</td><td>8 clocks</td></tr>
<tr><td>.....</td><td>.....</td><td>.....</td><td>.....</td><td>.....</td></tr>
<tr><td>11111</td><td>32 clocks</td><td>32 clocks</td><td>32 clocks</td><td>32 clocks</td></tr>
<tr><td colspan="5">Note 1: In this context, Flash writes are defined as writes to RCS2 while in Enhanced ROM/Flash control mode.
Note 2: For Flash writes only, add the write recovery time, RCS2_ROMNAL, to the given minimum tri-state disable time.
Note 3: In this context, Port X writes are defined as writes to RCS2 while in Port X Strobe or Port X handshake control mode.</td></tr>
</table>
</td></tr>
</table>

Table 4-42 describes the bit settings for extended ROM configuration register 2.

Table 4-42. Extended ROM Configuration Register 2—0xD4

Bits	Name	Reset Value	Description
msb 31	RCS3_EN	1	ROM chip-select 3 enable 0 RCS3 disabled 1 RCS3 enabled
30	RCS3_BURST	0	Burst mode ROM chip-select 3 timing enable 0 Indicates standard (nonburst) ROM access timing 1 Indicates burst-mode ROM access timing. When burst mode is enabled, ROM reads use RCS3_ROMNAL for burst beats.
29–28	RCS3_DBW	11	These bits control the of the data bus width for $\overline{\text{RCS3}}$. 00 8-bit data path with gathering 01 16-bit data path with gathering 10 32-bit data path with gathering. Gathering occurs if DBUS0 = 1. 11 wide data path; 64-bit if DBUS0 = 1, 32-bit if DBUS0 = 0
27–26	RCS3_CTL	01	This field determines the type of device and timing used for RCS3. 00 Independent RCS3 ROM/FLASH timing mode—$\overline{\text{RCS3}}$ uses the timing controls (RCS3_ROMFAL, RCS3_ROMNAL, and RCS3_TS_WAIT_TIMER, RCS3_ASFALL, and RCS3_ASRISE) set in this register. 01 Base ROM/FLASH timing mode—$\overline{\text{RCS3}}$ uses the same timing controls (ROMFAL, ROMNAL, and TS_WAIT_TIMER, ASFALL, and ASRISE) as the base ROM interface specified in the MCCRs. 10 RCS3 Port X strobe mode—See Section 6.3.5, “Port X Interface,” for more information. Note that flash recovery time is disabled in this mode. Also note that the relevant time parameters for this mode are RCS3_ROMFAL, RCS3_TS_WAIT_TIMER, RCS3_ASRISE and RCS3_ASFALL. 11 RCS3 Port X handshake mode—See Section 6.3.5, “Port X Interface,” for more information.Note that flash recovery time is disabled in this mode. Also note that the relevant time parameters for this mode are RCS3_ROMFAL, RCS3_TS_WAIT_TIMER, RCS3_ASRISE and RCS3_ASFALL.
25	—	0	Reserved
24–20	RCS3_ROMFAL	All 1s	For nonburst ROM and Flash reads, RCS3_ROMFAL controls the access time. For burst-mode ROMs, RCS3_ROMFAL controls the first access time. The maximum value is 0b11111 (31). For the 64-bit and 32-bit configurations, the actual cycle count is three cycles more than the binary value of RCS3_ROMFAL. For the 8-bit configuration, the actual cycle count is two cycles more than the binary value of RCS3_ROMFAL. For Flash writes, RCS3_ROMFAL measures the write pulse low time. The maximum value is 0b11111 (31). The actual cycle count is two cycles more than the binary value of RCS3_ROMFAL. Note that this timing is only in effect if ERCR2[RCS3_CTL] $\neq$ 01.
19–15	RCS3_ROMNAL	All 1s	For burst-mode ROM and Flash reads, RCS3_ROMNAL controls the next access time. The maximum value is 0b11111 (31). The actual cycle count is three cycles more than the binary value of RCS3_ROMNAL. For Flash writes, RCS3_ROMNAL measures the write pulse recovery (high) time. The maximum value is 0b11111 (31). The actual cycle count is four cycles more than the binary value of RCS3_ROMNAL. Note that this timing is only in effect if ERCR2[RCS3_CTL] = 00.

Table 4-42. Extended ROM Configuration Register 2—0xD4 (continued)

Bits	Name	Reset Value	Description
14–10	RCS3_ASFALL	All 0s	RCS3 $\overline{AS}$ fall time. These bits control the falling edge timing of the $\overline{AS}$ signal relative to the falling edge of $\overline{RCS3}$ for the Port X interface. See Section 6.3.5, “Port X Interface,” for more information. 00000 0 clocks ($\overline{AS}$ asserted coincident with the chip select) 00001 1 clock 00010 2 clocks 00011 3 clocks ... 11111 31 clocks
9–5	RCS3_ASRISE	All 0s	RCS3 $\overline{AS}$ rise time. These bits control the rising edge timing of the $\overline{AS}$ signal relative to the falling edge of $\overline{RCS3}$ for the Port X interface. See Section 6.3.5, “Port X Interface,” for more information. 00000 Disables $\overline{AS}$ signal generation 00001 1 clock 00010 2 clocks 00011 3 clocks ... 11111 31 clocks

Table 4-42. Extended ROM Configuration Register 2—0xD4 (continued)

<table>
<tr><th>Bits</th><th>Name</th><th>Reset Value</th><th>Description</th></tr>
<tr><td>4–0</td><td>RCS3_TS_WAIT_TIMER</td><td>All 0s</td><td>RCS3 Transaction start wait states timer. The minimum time allowed for ROM/Flash/Port X devices to enter high impedance is 2 memory system clocks. RCS3_TS_WAIT_TIMER[0–2] adds wait states before the subsequent transaction starts in order to account for longer disable times of a ROM/Flash/Port X device. This delay is enforced after all ROM and Flash accesses, delaying the next memory access from starting (for example, SDRAM after ROM access, SDRAM after Flash access, ROM after Flash access).
<table>
<tr><th rowspan="2">bits</th><th colspan="4">Wait States for ROM High Impedance</th></tr>
<tr><th>Reads with wide data path (32 or 64-bit)</th><th>Reads with gather data path in registered buffer mode (8, 16, 32-bit)</th><th>All Flash writes[1,2] and reads with gather data path in inline buffer mode (8, 16, 32,-bit)</th><th>All Port X writes [3]</th></tr>
<tr><td>00000</td><td>2 clocks</td><td>5 clocks</td><td>6 clocks</td><td>3 clocks</td></tr>
<tr><td>00001</td><td>2 clocks</td><td>5 clocks</td><td>6 clocks</td><td>3 clocks</td></tr>
<tr><td>00010</td><td>3 clocks</td><td>5 clocks</td><td>6 clocks</td><td>3 clocks</td></tr>
<tr><td>00011</td><td>4 clocks</td><td>5 clocks</td><td>6 clocks</td><td>4 clocks</td></tr>
<tr><td>00100</td><td>5 clocks</td><td>5 clocks</td><td>6 clocks</td><td>5 clocks</td></tr>
<tr><td>00101</td><td>6 clocks</td><td>6 clocks</td><td>6 clocks</td><td>6 clocks</td></tr>
<tr><td>00110</td><td>7 clocks</td><td>7 clocks</td><td>7 clocks</td><td>7 clocks</td></tr>
<tr><td>00111</td><td>8 clocks</td><td>8 clocks</td><td>8 clocks</td><td>8 clocks</td></tr>
<tr><td>.....</td><td>.....</td><td>.....</td><td>.....</td><td>.....</td></tr>
<tr><td>11111</td><td>32 clocks</td><td>32 clocks</td><td>32 clocks</td><td>32 clocks</td></tr>
<tr><td colspan="5">Note 1: In this context, Flash writes are defined as writes to RCS3 while in Enhanced ROM/Flash control mode.
Note 2: For Flash writes only, add the write recovery time, RCS3_ROMNAL, to the given minimum tri-state disable time.
Note 3: In this context, Port X writes are defined as writes to RCS3 while in Port X Strobe or Port X handshake control mode.</td></tr>
</table>
</td></tr>
</table>

Table 4-43 describes the bit settings for extended ROM configuration register 3. Figure 4-29 shows the bits for ERCR3 and ERCR4

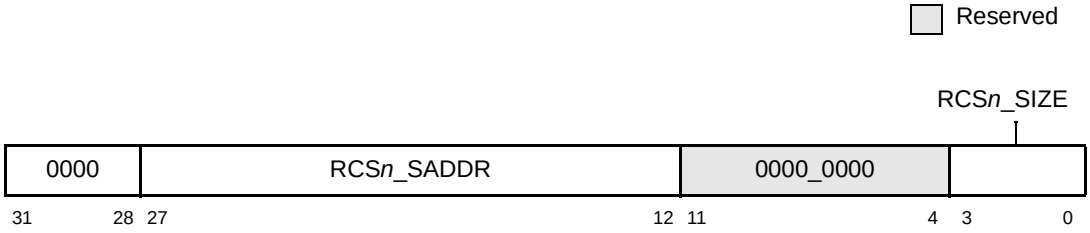


Figure 4-29. ERCR3 and ERCR4—0xD8, 0xDC

Table 4-43. Extended ROM Configuration Register 3—0xD8

Bits	Name	Reset Value	Description
msb 31–28	—	0x0	Reserved
27–12	RCS2_SADDR	0xC000	Starting address for $\overline{\text{RCS2}}$ in megabytes. Physical starting address = 0x7 || RCS2_SADDR || 0x000
11–4	—	0x00	Reserved
3–0	RCS2_SIZE	0b1110	Encoded size of RCS2 (see table below). 0000 = 4 Kbytes 0100 = 64 Kbytes 1000 = 1 Mbyte 1100 = 16 Mbytes 0001 = 8 Kbytes 0101 = 128 Kbytes 1001 = 2 Mbytes 1101 = 32 Mbytes 0010 = 16 Kbytes 0110 = 256 Kbytes 1010 = 4 Mbytes 1110 = 64 Mbytes 0011 = 32 Kbytes 0111 = 512 Kbyte 1011 = 8 Mbytes 1111 = 128 Mbytes 1110 is the default setting for RCS2_SIZE.

Table 4-44 describes the bit setting for extended ROM configuration register 4.

Table 4-44. Extended ROM Configuration Register 4—0xDC

Bits	Name	Reset Value	Description
msb 31–28	—	0x0	Reserved
27–12	RCS3_SADDR	0xC000	Starting address for $\overline{\text{RCS3}}$ in megabytes. Physical starting address = 0x7 || RCS3_SADDR || 0x000

Bits	Name	Reset Value	Description
11–4	—	0x00	Reserved
3–0	RCS3_SIZE	0b1110	Encoded size of RCS3 (see table below). 0000 = 4 Kbytes 0100 = 64 Kbytes 1000 = 1 Mbytes 1100 = 16 Mbytes 0001 = 8 Kbytes 0101 = 128 Kbytes 1001 = 2 Mbytes 1101 = 32 Mbytes 0010 = 16 Kbytes 0110 = 256 Kbytes 1010 = 4 Mbytes 1110 = 64 Mbytes 0011 = 32 Kbytes 0111 = 512 Kbytes 1011 = 8 Mbytes 1111 = 128 Mbytes 1110 is the default setting for RCS3_SIZE.

4.10 Address Map B Options Register—0xE0

The address map B options register (AMBOR) controls various configuration settings that can be used to alias some addresses and to control accesses to holes in the address map. Figure 4-30 shows the bits of the AMBOR.

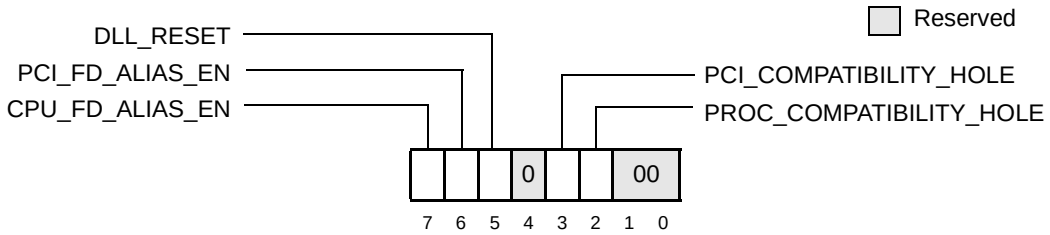


Figure 4-30. Address Map B Options Register (AMBOR)—0xE0

Table 4-45 shows the specific bit settings for the AMBOR.

Table 4-45. Bit Settings for the AMBOR—0xE0

Bits	Name	Reset Value	Description
7	CPU_FD_ALIAS_EN	1	Used to direct processor accesses to addresses that begin with 0xFDxx_xxxx. This bit is used only for address map B (and not supported in agent mode). 0 Access are routed normally 1 Processor accesses with 0xFDxx_xxxx address are forwarded to the PCI bus as PCI memory accesses to 0x00xx_xxxx.
6	PCI_FD_ALIAS_EN	1	Used to direct processor responses to addresses that begin with 0xFDxx_xxxx. This bit is used only for address map B (and not supported in agent mode). 0 No response 1 The MPC8245, as a PCI target, responds to addresses in the range 0xFD00_0000–0xFDFF_FFFF (asserts $\overline{\text{DEVSEL}}$), and forwards the transaction to system memory as 0x0000_0000–0x00FF_FFFF.

Table 4-45. Bit Settings for the AMBOR—0xE0 (continued)

Bits	Name	Reset Value	Description
5	DLL_RESET	0	Used to reset the DLL tap point. See Section 2.3.2, “DLL Operation and Locking.” This bit must be explicitly set and then cleared by software during initialization in order to guarantee correct operation of the DLL and the SDRAM_CLK[0:3] signals (if they are used). See the hardware specification document for more details on the DLL locking modes and their related graphs. 0 DLL tries to lock the phase between the SDRAM_SYNC_IN signal and the internal *sys_logic_clk* signal. 1 The SDRAM_CLK signals are driven from tap point 0 of the internal delay line.
4	—	0	Reserved
3	PCI_COMPATIBILITY_HOLE	0	This bit is used only for address map B (not supported in agent mode). 0 The MPC8245, as a PCI target, responds to PCI addresses in the range 0x000A_0000–0x000F_FFFF and forwards the transaction to system memory. 1 The MPC8245, as a PCI target, does not respond to PCI addresses in the range 0x000A_0000–0x000F_FFFF.
2	PROC_COMPATIBILITY_HOLE	0	This bit is used only for address map B (not supported in agent mode). 0 The MPC8245 forwards processor-initiated transactions in the address range 0x000A_0000–0x000B_FFFF to system memory. 1 The MPC8245 forwards processor-initiated transactions in the address range 0x000A_0000–0x000B_FFFF to the PCI memory space.
1–0	—	00	Reserved

4.11 PCI/Memory Buffer Configuration Register—0xE1

The PCI/Memory buffer configuration register (PCMBCR) controls various configuration settings. Figure 4-31 shows the bits of the PCMBCR.

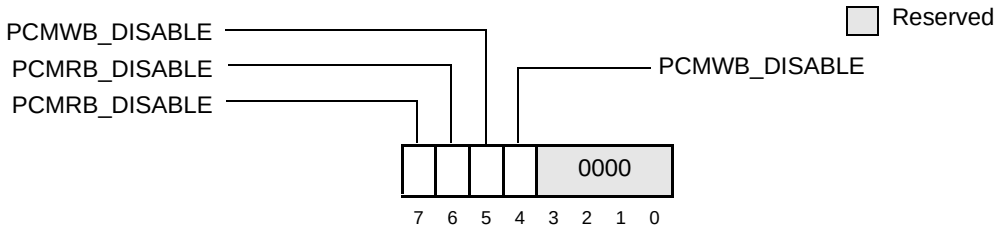


Figure 4-31. PCI/Memory Buffer Configuration Register (PCMBCR)—0xE1

Table 4-46 shows the specific bit settings for this register.

Table 4-46. Bit Settings for this register—0xE1

Bits	Name	Reset Value	Description
7–6	PCMRB_DISABLE	00	These bits control the number of PCMRB that the MPC8245 uses. This parameter is primarily used for system debugging. For maximum performance, all PCMRBs should be enabled. 00 All (4) PCMRBs enabled 01 1 PCMRB disabled; 3 PCMRBs available 10 2 PCMRBs disabled; 2 PCMRBs available 11 3 PCMRBs disabled; 1 PCMRBs available
5–4	PCMWB_DISABLE	00	These bits control the number of PCMWBs that the MPC8245. uses. This parameter is primarily used for system debugging. For maximum performance, all PCMWBs should be enabled. 00 All (4) PCMWBs enabled 01 1 PCMWB disabled; 3 PCMWBs available 10 2 PCMWBs disabled; 2 PCMWBs available 11 3 PCMWBs disabled; 1 PCMWB available
3–0	—	0	Reserved

4.12 PLL Configuration Register—0xE2

The PLL configuration register (PCR) indicates the values used to set the PLL mode. See *MPC8245 Integrated Processor Hardware Specifications* for more information. Figure 4-32 shows the bits of the PCR.

Figure 4-32. PLL Configuration Register (PCR)—0xE2

Table 4-47 shows the specific bit settings for the PLL Configuration Register.

Table 4-47. Bit Settings for the PCR—0xE2

Bits	Name	Reset Value	Description
7–3	PLL_CFG	x [1]	PLL Configuration. Indicates the values used to set the PLL mode.
2–0	—	000	Reserved

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.13 Register—0xE3

Table 4-48 shows the specific bit settings for this register.

Table 4-48. Bit Settings for this Register—0xE3

Bits	Name	Reset Value	Description
7	HOST_MODE	x [1]	Determines mode of MPC8245.This bit is read only. 1 MPC8245 is in host mode 0 MPC8245 is in agent mode
6–0	DLL_TAP_COUNT	xx	DLL_TAP_COUNT provides the value of the current DLL tap point. This value can determine if the DLL has stabilized or if the DLL is advancing or decrementing

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.14 Memory Control Configuration Registers

The four 32-bit memory control configuration registers (MCCRs) set all RAM and ROM parameters. These registers are programmed by initialization software to adapt the MPC8245 to the specific memory organization used in the system. After all the memory configuration parameters have been properly configured, the initialization software turns on the memory interface using the MEMGO bit in MCCR1.

Note that the RAM_TYPE bit in MCCR1 must be cleared (to select SDRAM mode) before either the REGISTERED or buffer mode bits in MCCR4 are set to one. It is recommended that the user should write MCCR1, 2, 3, and 4 first, in order, without setting the MEMGO bit. Afterwards, the user should perform a read-modify-write operation to set the MEMGO bit in MCCR1.

Figure 4-33 and Table 4-49 show the memory control configuration register 1 (MCCR1) format and bit settings.

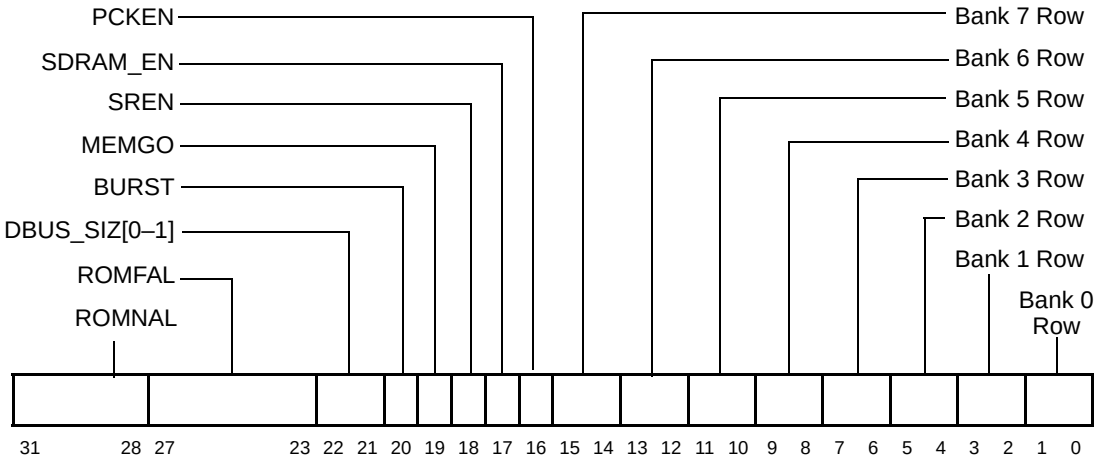


Figure 4-33. Memory Control Configuration Register 1 (MCCR1)—0xF0

Table 4-49. Bit Settings for MCCR1—0xF0

Bits	Name	Reset Value	Description
31–28	ROMNAL	All 1s	For burst-mode ROM and Flash reads, ROMNAL controls the next access time. The maximum value is 0b1111 (15). The actual cycle count is three cycles more than the binary value of ROMNAL. For Flash writes, ROMNAL measures the write pulse recovery (high) time. The maximum value is 0b1111 (15). The actual cycle count is four cycles more than the binary value of ROMNAL.
27–23	ROMFAL	All 1s	For nonburst ROM and Flash reads, ROMFAL controls the access time. For burst-mode ROMs, RCS2_ROMFAL controls the first access time. The maximum value is 0b11111 (31). For the 64-bit and 32-bit configurations, the actual cycle count is three cycles more than the binary value of ROMFAL. For the 8-bit configuration, the actual cycle count is two cycles more than the binary value of ROMFAL. For Flash writes, ROMFAL measures the write pulse low time. The maximum value is 0b11111 (31). The actual cycle count is two cycles more than the binary value of ROMFAL.
22–21	DBUS_SIZ[0–1]	xx	Read-only. This field indicates the state of the memory data path width. The value of this field is determined by the reset configuration signals [DL[0], $\overline{\text{FOE}}$]. Used with DBUS_SIZ2 (stored in MCCR4[17]) as shown below. DBUS_SIZ[0–2]: For SDRAM: 0nn 32-bit data bus 1nn 64-bit data bus For ROM/Flash chip select #0 ($\overline{\text{RCSO}}$): 00n 32-bit data bus n1n 8-bit data bus 10n 64-bit data bus For ROM/Flash chip select #1 ($\overline{\text{RCS1}}$): 0n0 32-bit data bus nn1 8-bit data bus 1n0 64-bit data bus For ROM/Flash chip select #2 ($\overline{\text{RCS2}}$) and ROM/Flash chip select #3 ($\overline{\text{RCS3}}$) data bus width is set by ERCR1[RCS2_DBW] and ERCR2[RCS2_DBW], respectively.
20	BURST	0	Burst mode ROM timing enable 0 Indicates standard (nonburst) ROM access timing 1 Indicates burst-mode ROM access timing
19	MEMGO	0	RAM interface logic enable. Note that this bit must not be set until all other memory configuration parameters have been appropriately configured by boot code. 0 MPC8245 RAM interface logic disabled 1 MPC8245 RAM interface logic enabled
18	SREN	0	Self-refresh enable. Note that if self refresh is disabled, the system is responsible for preserving the integrity of SDRAM during sleep mode. 0 Disables the SDRAM self refresh during sleep mode 1 Enables the SDRAM self refresh during sleep mode

Table 4-49. Bit Settings for MCCR1—0xF0 (continued)

Bits	Name	Reset Value	Description
17	SDRAM_EN	1	SDRAM enable bit 0 Enables SDRAM 1 Disables SDRAM Note that this bit must be set to 0 (SDRAM enabled) before transitioning to registered or in-line buffer modes through the MCCR4[BUF_TYPE[0–1]] field and before setting the MEMGO bit.
16	PCKEN	0	Memory interface parity checking/generation enable 0 Disables parity checking and parity generation for transactions to SDRAM memory. Note that this bit must be cleared for SDRAM memory when operating in inline buffer mode (MCCR4[BUF_TYPE[0–1]] = 0b10) and in-line parity/ECC is enabled with MCCR2[INLINE_RD_EN] = 1. 1 Enables parity checking and generation for all registered mode memory transactions to SDRAM memory.
15–14	Bank 7 row	00	RAM bank 7 row address bit count. These bits indicate the number of row address bits that are required by the RAM devices in bank 7. For SDRAM configurations (SDRAM_EN = 0), the encoding is as follows: 00 12 row bits by n column bits by 4 logical banks (12 × n × 4) or 11 row bits by n column bits by 4 logical banks (11 × n × 4) 01 Reserved 10 13 row bits by n column bits by 4 logical banks (13 × n × 4) 11 11 row bits by n column bits by 2 logical banks (11 × n × 2)
13–12	Bank 6 row	00	RAM bank 6 row address bit count. See the description for Bank 7 row (bits 15–14).
11–10	Bank 5 row	00	RAM bank 5 row address bit count. See the description for Bank 7 row (bits 15–14).
9–8	Bank 4 row	00	RAM bank 4 row address bit count. See the description for Bank 7 row (bits 15–14).
7–6	Bank 3 row	00	RAM bank 3 row address bit count. See the description for Bank 7 row (bits 15–14).
5–4	Bank 2 row	00	RAM bank 2 row address bit count. See the description for Bank 7 row (bits 15–14).
3–2	Bank 1 row	00	RAM bank 1 row address bit count.See the description for Bank 7 row (bits 15–14).
1–0	Bank 0 row	00	RAM bank 0 row address bit count. See the description for Bank 7 row (bits 15–14).

Figure 4-34 and Table 4-50 show the memory control configuration register 2 (MCCR2) format and bit settings.

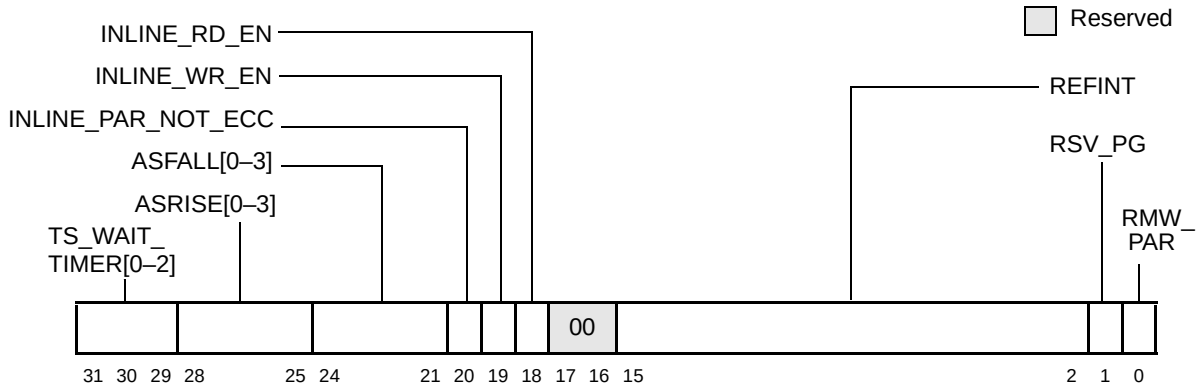


Figure 4-34. Memory Control Configuration Register 2 (MCCR2)—0xF4

Table 4-50. Bit Settings for MCCR2—0xF4

<table>
<tr><th>Bits</th><th>Name</th><th>Reset Value</th><th>Description</th></tr>
<tr><td>31–29</td><td>TS_WAIT_ TIMER[0–2]</td><td>000</td><td>Transaction start wait states timer. The minimum time allowed for ROM/Flash/Port X devices to enter high impedance is 2 memory system clocks. TS_WAIT_TIMER[0–2] adds wait states before the subsequent transaction starts in order to account for longer disable times of a ROM/Flash/Port X device. This delay is enforced after all ROM and Flash accesses, delaying the next memory access from starting (for example, SDRAM after ROM access, SDRAM after Flash access, ROM after Flash access).
<table>
<tr><th rowspan="2">Bits</th><th colspan="3">Wait States for ROM High Impedance</th></tr>
<tr><th>Reads with wide data path (32 or 64-bit)</th><th>Reads with gather data path in flow-through or registered buffer mode (8, 16, 32, 64-bit)</th><th>All writes[1, 2] and reads with gather data path in inline buffer mode (8, 16, 32, 64-bit)</th></tr>
<tr><td>000</td><td>2 clocks</td><td>5 clocks</td><td>6 clocks</td></tr>
<tr><td>001</td><td>2 clocks</td><td>5 clocks</td><td>6 clocks</td></tr>
<tr><td>010</td><td>3 clocks</td><td>5 clocks</td><td>6 clocks</td></tr>
<tr><td>011</td><td>4 clocks</td><td>5 clocks</td><td>6 clocks</td></tr>
<tr><td>100</td><td>5 clocks</td><td>5 clocks</td><td>6 clocks</td></tr>
<tr><td>101</td><td>6 clocks</td><td>6 clocks</td><td>7 clocks</td></tr>
<tr><td>110</td><td>7 clocks</td><td>7 clocks</td><td>8 clocks</td></tr>
<tr><td>111</td><td>8 clocks</td><td>8 clocks</td><td>9 clocks</td></tr>
</table>
Note 1. In this context, Flash writes are defined as any write to $\overline{\text{RCS0}}$ or $\overline{\text{RCS1}}$ or either $\overline{\text{RCS2}}$ or $\overline{\text{RCS3}}$ while in ROM/Flash control mode respectively.
Note 2: For Flash writes, add the write recovery time, ROMNAL, to the given wait states for ROM high-impedance time.</td></tr>
<tr><td>28–25</td><td>ASRISE[0–3]</td><td>0000</td><td>$\overline{\text{AS}}$ rise time. These bits control the rising edge timing of the $\overline{\text{AS}}$ signal for the Port X interface. See Section 6.3.5, “Port X Interface,” for more information.
0000 Disables $\overline{\text{AS}}$ signal generation
0001 1 clock
0010 2 clocks
0011 3 clocks
...
1111 15 clocks</td></tr>
</table>

Table 4-50. Bit Settings for MCCR2—0xF4 (continued)

Bits	Name	Reset Value	Description
24–21	ASFALL[0–3]	0000	$\overline{AS}$ fall time. These bits control the falling edge timing of the $\overline{AS}$ signal for the Port X interface. See Section 6.3.5, “Port X Interface,” for more information. 0000 0 clocks ($\overline{AS}$ asserted coincident with the chip select) 0001 1 clock 0010 2 clocks 0011 3 clocks ... 1111 15 clocks
20	INLINE_PAR_ NOT_ECC	0	In-line parity, not ECC. This bit selects between the ECC and parity checking/correction mechanisms of the in-line data path when performing memory reads. This bit is applicable for SDRAM systems running in inline buffer mode (MCCR4[BUF_TYPE[0–1]] = 0b10) only, and when INLINE_RD_EN = 1. 0 MPC8245 uses ECC on the memory data bus. 1 MPC8245 uses parity on the memory data bus.
19	INLINE_WR_EN	0	In-line parity error reporting enable. This bit controls whether the MPC8245 uses the in-line parity hardware to report peripheral bus parity errors on writes to memory and to generate new parity for the data being written. Note that the buffer type selector in MCCR4 must be set to in-line buffer mode (MCCR4[BUF_TYPE[0–1]] = 0b10) to enable the in-line ECC/parity logic. 0 In-line bus parity error reporting disabled 1 In-line bus parity error reporting enabled
18	INLINE_RD_ EN	0	In-line read parity or ECC check/correction enable. This bit controls whether the MPC8245 uses the ECC/parity checking and/or correction hardware in the in-line data path to report ECC or parity errors on memory system read operations. This bit activates different parity/ECC checking/correction hardware than that controlled by PCKEN. Read parity/ECC checking can be enabled for SDRAM systems running in inline buffer mode (MCCR4[BUF_TYPE[0–1]] = 0b10) only. Also, note that the INLINE_PAR_NOT_ECC bit selects between parity or ECC on the memory data bus when this bit is set. 0 In-line memory bus read parity/ECC error reporting disabled 1 In-line memory bus read parity/ECC error reporting enabled. Note that MCCR1[PCKEN] must be cleared when this bit is set.
17–16	—	00	Reserved
15–2	REFINT	All 0s	Refresh interval. These bits directly represent the number of clock cycles between CBR refresh cycles. One row is refreshed in each RAM bank during each CBR refresh cycle. The value for REFINT depends on the specific RAMs used and the operating frequency of the MPC8245. See Section 6.2.12, “SDRAM Refresh,” for more information. Note that the period of the refresh interval must be greater than the read/write access time to ensure that read/write operations complete successfully.

Table 4-50. Bit Settings for MCCR2—0xF4 (continued)

Bits	Name	Reset Value	Description
1	RSV_PG	0	Reserve page register. If this bit is set, the MPC8245 reserves one of the four page registers at all times. This is equivalent to only allowing three simultaneous open pages. 0 Four open page mode (default) 1 Reserve one of the four page registers at all times
0	RMW_PAR	0	Read-modify-write (RMW) parity enable. This bit controls how the MPC8245 writes parity bits to SDRAM. Note that this bit does not enable parity checking and generation. PCKEN must be set to enable parity checking. See Section 6.2.9, “SDRAM Parity and RMW Parity,” for more information. 0 RMW parity disabled 1 RMW parity enabled. Note that this bit must be set for SDRAM systems that use in-line ECC (MCCR4[BUF_TYPE[0–1]] = 0b10 and MCCR2[INLINE_PAR_NOT_ECC]] = 0).

Figure 4-35 and Table 4-51 show memory control configuration register 3 (MCCR3) format and bit settings.

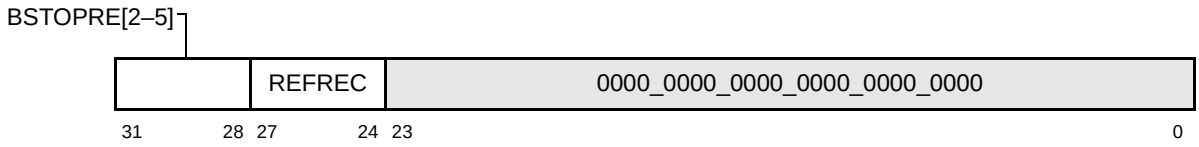


Figure 4-35. Memory Control Configuration Register 3 (MCCR3)—0xF8

Table 4-51. Bit Settings for MCCR3—0xF8

Bits	Name	Reset Value	Description
31–28	BSTOPRE[2–5]	0000	Burst to precharge—bits 2–5. These bits, together with BSTOPRE[0–1] (bits 19–18 of MCCR4), and BSTOPRE[6–9] (bits 3–0 of MCCR4), control the open page interval. The page open duration counter is reloaded with BSTOPRE[0–9] every time the page is accessed (including page hits). When the counter expires, the open page is closed with a SDRAM-precharge bank command. Section 6.2.7, “SDRAM Page Mode,” for more information.
27–24	REFREC	0000	Refresh to activate interval. These bits control the number of clock cycles from an SDRAM-refresh command until an SDRAM-activate command is allowed. See Section 6.2.12, “SDRAM Refresh,” for more information. 0001 1 clock 0010 2 clocks 0011 3 clocks ... ... 1111 15 clocks 0000 16 clocks
23–0	—	All 0s	Reserved

Figure 4-36 and Table 4-52 show memory control configuration register 4 (MCCR4) format and bit settings.

Figure 4-36. Memory Control Configuration Register 4 (MCCR4)—0xFC

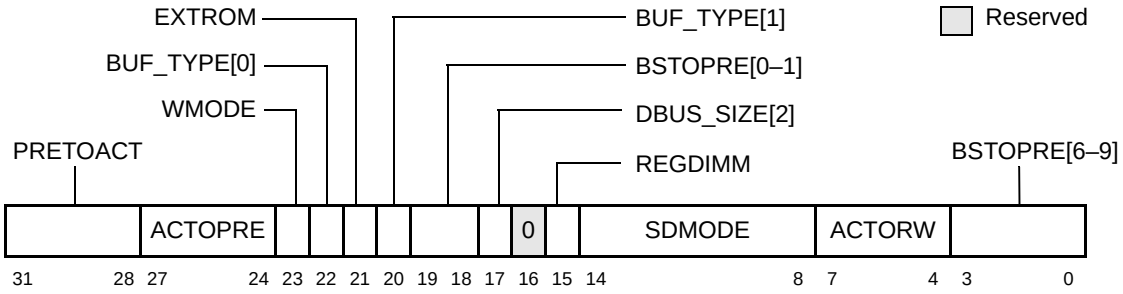


Table 4-52. Bit Settings for MCCR4—0xFC

Bits	Name	Reset Value	Description
31–28	PRETOACT	0000	Precharge to activate interval. These bits control the number of clock cycles from an SDRAM-precharge command until an SDRAM-activate command is allowed. See Section 6.2.4, “SDRAM Power-On Initialization,” for more information. 0001 1 clock 0010 2 clocks 0011 3 clocks ... ... 1111 15 clocks 0000 16 clocks
27–24	ACTOPRE	0000	Activate to precharge interval. These bits control the number of clock cycles from an SDRAM-activate command until an SDRAM-precharge command is allowed. See Section 6.2.4, “SDRAM Power-On Initialization,” for more information. 0001 1 clock 0010 2 clocks 0011 3 clocks ... ... 1111 15 clocks 0000 16 clocks
23	WMODE	0	Length of burst for 32-bit data. Applies to 32-bit data path mode only. Determines whether the burst ROMs can accept eight beats in a burst or only four. In 32-bit data path mode, burst transactions require data beats. If the burst ROM can only accept four beats per burst, the memory controller must perform two transactions to the ROM. 0 Four beats per burst (default) 1 Eight beats per burst

Table 4-52. Bit Settings for MCCR4—0xFC (continued)

Bits	Name	Reset Value	Description
22	BUF_TYPE[0]	0	Most significant bit of the memory data bus buffer type field. BUF_TYPE[0] is used with bit 20 below (BUF_TYPE[1]) to configure the internal memory data path buffering scheme as follows: BUF_TYPE[0–1]: 00 Reserved 01 Registered buffer mode (default) 10 In-line buffer mode; SDRAM only 11 Reserved The MPC8245 must be configured for in-line buffer mode in order to use the in-line ECC/parity logic for SDRAM. The in-line ECC and parity hardware allow the MPC8245 to check/generate parity on the internal peripheral logic bus and check/correct/generate ECC or parity on the external SDRAM memory bus. See Section 6.2.3, “SDRAM Memory Data Interface,” for more information.
21	EXTROM	0	Extended ROM space enable 0 Extended ROM disabled 1 Extended 256 Mbytes of local ROM memory space enabled
20	BUF_TYPE[1]	1	Least significant bit of the memory data bus buffer type field. BUF_TYPE[1] is used with bit 22 above (BUF_TYPE[0]) to configure the internal memory data path buffering scheme as described for bit 22.
19–18	BSTOPRE[0–1]	00	Burst to precharge—bits 0–1. These bits, together with BSTOPRE[2–5] (bits 31–28 of MCCR3), and BSTOPRE[6–9] (bits 3–0 of MCCR4), control the open page interval. The page open duration counter is reloaded with BSTOPRE[0–9] every time the page is accessed (including page hits). When the counter expires, the open page is closed with a SDRAM-precharge bank command. See Chapter 6, “Memory Interface,” for more information.
17	DBUS_SIZE[2]	0	See description for bits 22–21 of MCCR1.
16	—	0	Reserved
15	REGDIMM	0	Registered DIMMs. Memory data and parity data path buses configured for registered DIMMs. When enabled (REGDIMM = 1), SDRAM write data and parity are delayed by one cycle on the memory bus with respect to the SDRAM control signals (for example, $\overline{\text{SDRAS}}$, $\overline{\text{SDCAS}}$, $\overline{\text{WE}}$). 0 Normal DIMMs 1 Registered DIMMs selected

Table 4-52. Bit Settings for MCCR4—0xFC (continued)

Bits	Name	Reset Value	Description
14–8	SDMODE	All 0s	SDRAM mode register. These bits specify the SDRAM mode register data to be written to the SDRAM array during power-up configuration. Note that the SDRAM mode register 'opcode' field is not specified and is forced to 0 by the MPC8245 when the mode registers are written. Bits 14–12 CAS latency 000 Reserved 001 1 010 2 011 3 100 Reserved 101 Reserved 110 Reserved 111 Reserved Bit 11 Wrap type 0 Sequential. Default for MPC8245 1 Interleaved - Reserved Bits 10–8 Burst length 000 Reserved 001 Reserved 010 4 011 8 100 Reserved 101 Reserved 110 Reserved 111 Reserved
7–4	ACTORW	0000	Activate to read/write interval. These bits control the number of clock cycles from an SDRAM-activate command until an SDRAM-read or SDRAM-write command is allowed. See Section 6.2.4, "SDRAM Power-On Initialization," for more information. 0001 Reserved 0010 2 clocks (minimum for registered data interfaces) 0011 3 clocks (minimum for in-line ECC/parity data interfaces) ... ... 1111 15 clocks 0000 16 clocks
3–0	BSTOPRE[6–9]	0000	Burst to precharge—bits 6–9. These bits, together with BSTOPRE[0–1] (bits 19–18 of MCCR4), and BSTOPRE[2–5] (bits 31–28 of MCCR3), control the open page interval. The page open duration counter is reloaded with BSTOPRE[0–9] every time the page is accessed (including page hits). When the counter expires, the open page is closed with a SDRAM-precharge bank command. See Chapter 6, "Memory Interface," for more information.

Chapter 5
G2 Processor Core

The MPC8245 contains an embedded version of the MPC603e processor called the G2 processor core. This chapter provides an overview of the basic functionality of the processor core. For detailed information regarding the processor refer to the following:

- *MPC603e RISC Microprocessor User's Manual* (chapters that include the following topics):
  - — Programming mode
  - — Cache model
  - — Memory management model
  - — Exception model
  - — Instruction timing
- *Programming Environments Manual for 32-Bit Implementations of the PowerPC Architecture*

The following section describes the details of the processor core, provides a block diagram showing the major functional units, and describes briefly how those units interact. At the end of this chapter, a section outlines detailed differences between the processor core and the MPC8245 processor.

The signals associated with the processor core are described in Chapter 2, "Signal Descriptions and Clocking."

5.1 Overview

The processor core is a low-power implementation of the family of microprocessors that implement the PowerPC architecture. The processor core implements the 32-bit portion of the PowerPC architecture, which supports 32-bit effective addresses.

Figure 5-1 is a block diagram of the processor core.

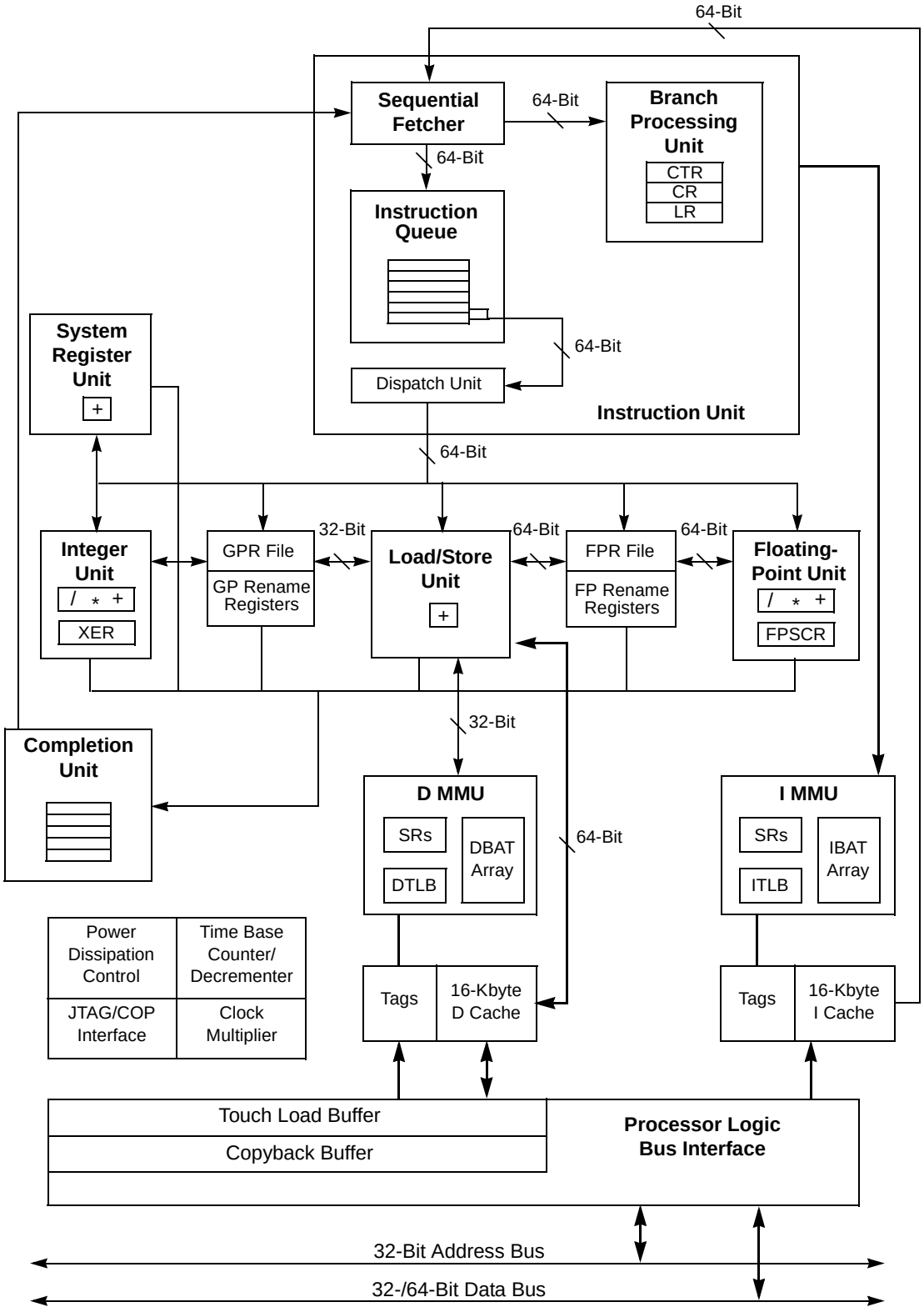


Figure 5-1. MPC8245 Integrated Processor Core Block Diagram

The processor core is a superscalar processor that can issue and retire as many as three instructions per clock. Instructions can execute out of order for increased performance; however, the processor core makes completion appear sequential.

5.1.1 Execution Units

The processor core integrates the following five execution units:

- Integer unit (IU)
- Floating-point unit (FPU)
- Branch processing unit (BPU)
- Load/store unit (LSU)
- System register unit (SRU)

The ability to execute five instructions in parallel and use simple instructions with rapid execution times yields high efficiency and throughput. Most integer instructions execute in one clock cycle. On the processor core, the FPU is pipelined so that a single-precision multiply-add instruction can be issued and completed every clock cycle.

5.1.2 Data Types

The processor core supports integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits.

5.1.3 Memory Management

The processor core provides separate on-chip, 16-Kbyte, four-way set-associative, physically-addressed instruction and data caches. The processor also features independent on-chip instruction and data memory management units (MMUs). The MMUs contain 64-entry, two-way set-associative, data and instruction translation lookaside buffers (DTLB and ITLB) that provide support for demand-paged virtual memory address translation and variable-sized block translation. The TLBs and caches use a least recently used (LRU) replacement algorithm. The processor core also supports block address translation through the use of two independent instruction and data block address translation (IBAT and DBAT) arrays of four entries each. Effective addresses are compared simultaneously with all four entries in the BAT array during block translation. In accordance with the PowerPC architecture, if an effective address hits in both the TLB and BAT array, the BAT translation takes priority.

As an added feature to the MPC603e core, the MPC8245 can lock the contents of 1–3 ways in the instruction and data cache (or an entire cache), allowing embedded applications to lock interrupt routines or other important (time-sensitive) instruction sequences into the instruction cache. Data can be locked into the data cache, which may be important to code that must have deterministic execution.

5.1.4 Bus Operation

The processor core has a selectable 32- or 64-bit data bus and a 32-bit address bus. The processor core supports single-beat and burst data transfers for memory accesses and memory-mapped I/O operations.

5.2 G2 Processor Core Features

This section describes the major features of the processor core:

- High-performance, superscalar microprocessor
  - — As many as three instructions issued and retired per clock cycle
  - — As many as five instructions in execution per clock cycle
  - — Single-cycle execution for most instructions
  - — Pipelined FPU for all single-precision and most double-precision operations
- Five independent execution units and two register files
  - — BPU featuring static branch prediction
  - — A 32-bit IU
  - — Fully IEEE 754-compliant FPU for both single- and double-precision operations
  - — LSU for data transfer between data cache and GPRs and FPRs
  - — SRU that executes condition register (CR), special-purpose register (SPR), and integer add/compare instructions
  - — Thirty-two GPRs for integer operands
  - — Thirty-two FPRs for single- or double-precision operands
- High instruction and data throughput
  - — Zero-cycle branch capability (branch folding)
  - — Programmable static branch prediction on unresolved conditional branches
  - — BPU that performs CR lookahead operations
  - — Instruction fetch unit capable of fetching two instructions per clock from the instruction cache
  - — A six-entry instruction queue that provides lookahead capability
  - — Independent pipelines with feed-forwarding that reduces data dependencies in hardware
  - — 16-Kbyte data cache—four-way set-associative, physically addressed, LRU replacement algorithm
  - — 16-Kbyte instruction cache—four-way set-associative, physically addressed, LRU replacement algorithm

  - — Cache write-back or write-through operation programmable on a per-page or per-block basis
  - — Address translation facilities for 4-Kbyte page size, variable block size, and 256-Mbyte segment size
  - — A 64-entry, two-way set-associative ITLB
  - — A 64-entry, two-way set-associative DTLB
  - — Four-entry data and instruction BAT arrays providing 128-Kbyte to 256-Mbyte blocks
  - — Software table search operations and updates supported through fast trap mechanism
  - — 52-bit virtual address; 32-bit physical address
- Facilities for enhanced system performance
  - — A 32- or 64-bit split-transaction internal data bus interface to the peripheral logic bus with bursting
  - — Support for one-level address pipelining and out-of-order bus transactions
  - — Hardware support for misaligned little-endian accesses
  - — Configurable processor bus frequency multipliers as defined in the *MPC8245 Integrated Processor Hardware Specifications*
- Integrated power management
  - — Three power-saving modes: doze, nap, and sleep
  - — Automatic dynamic power reduction when internal functional units are idle
- Deterministic behavior and debug features
  - — Lockable L1 instruction and data caches—entire cache or on a per-way basis up to 3 of 4 ways
  - — In-system testability and debugging features through JTAG and boundary-scan capability

Figure 5-1 shows how the execution units (IU, BPU, FPU, LSU, and SRU) operate independently and in parallel. Note that this diagram is conceptual and does not portray the physical implementation of the features on the chip.

5.2.1 Instruction Unit

As shown in Figure 5-1, the instruction unit, which contains a fetch unit, instruction queue, dispatch unit, and the BPU, provides centralized control of instruction flow to the execution units. The instruction unit determines the address of the next instruction to be fetched, using information from the sequential fetcher and from the BPU.

The instruction unit fetches the instructions from the instruction cache into the instruction queue. The BPU extracts branch instructions from the fetcher and uses static branch prediction on unresolved conditional branches to allow the instruction unit to fetch instructions from a predicted target instruction stream while a conditional branch is evaluated. The BPU folds out branch instructions for unconditional branches or conditional branches that instructions in progress in the execution pipeline do not affect.

Instructions issued beyond a predicted branch do not complete execution until the branch is resolved, preserving the programming model of sequential execution. If any of these instructions are executed in the BPU, they are decoded but not issued. Instructions that the IU, FPU, LSU, and SRU execute are issued and allowed to complete up to the register write-back stage. Write-back is allowed when a correctly predicted branch is resolved, and instruction execution continues without interruption on the predicted path. If branch prediction is incorrect, the instruction unit flushes all predicted path instructions, and issues instructions from the correct path.

5.2.2 Instruction Queue and Dispatch Unit

The instruction queue (IQ), shown in Figure 5-1, holds as many as six instructions and loads up to two instructions from the instruction unit during a single cycle. The instruction fetch unit continuously loads as many instructions as the space in the IQ allows. Instructions are dispatched to their respective execution units from the dispatch unit at a maximum rate of two instructions per cycle. Reservation stations at the IU, FPU, LSU, and SRU facilitate instruction dispatch to those units. The dispatch unit checks for source and destination register dependencies, determines dispatch serializations, and inhibits subsequent instruction dispatching as required. Section 5.7, “Instruction Timing,” describes instruction dispatch in detail.

5.2.3 Branch Processing Unit (BPU)

The BPU receives branch instructions from the fetch unit and performs CR lookahead operations on conditional branches to resolve them early, achieving the effect of a zero-cycle branch in many cases.

The BPU uses a bit in the instruction encoding to predict the direction of the conditional branch. When an unresolved conditional branch instruction is encountered, instructions are fetched from the predicted target stream until the conditional branch is resolved.

The BPU contains an adder to compute branch target addresses and three user-control registers—the link register (LR), the count register (CTR), and the condition register (CR). The BPU calculates the return pointer for subroutine calls and saves it into the LR for certain types of branch instructions. The LR also contains the branch target address for the Branch Conditional to Link Register (**bclrx**) instruction. The CTR contains the branch target address for the Branch Conditional to Count Register (**bcctrx**) instruction. The

contents of the LR and CTR can be copied to or from any GPR. Because the BPU uses dedicated registers rather than GPRs or FPRs, execution of branch instructions is generally independent from execution of other instructions.

5.2.4 Independent Execution Units

PowerPC architecture support for independent execution units allows implementation of processors with out-of-order instruction execution. For example, because branch instructions do not depend on GPRs or FPRs, branches can often be resolved early, eliminating stalls that taken branches cause.

In addition to the BPU, the processor core provides four other execution units and a completion unit, which are described in the following sections.

5.2.4.1 Integer Unit (IU)

The Integer Unit (IU) executes all integer instructions. The IU executes one integer instruction at a time, performing computations with its arithmetic logic unit (ALU), multiplier, divider, and XER register. Most integer instructions are single-cycle instructions. Thirty-two general-purpose registers support integer operations. Automatic allocation of rename registers minimize stalls that contention for GPRs cause. The processor core writes the contents of the rename registers to the appropriate GPR when integer instructions the completion unit retires them.

5.2.4.2 Floating-Point Unit (FPU)

The Floating-Point Unit **(**FPU) contains a single-precision multiply-add array and the floating-point status and control register (FPSCR). The multiply-add array allows the processor to implement multiply and multiply-add operations efficiently. The FPU is pipelined so that single-precision instructions and double-precision instructions can be issued back-to-back. Thirty-two floating-point registers support floating-point operations. Automatic allocation of rename registers minimize stalls that contention for FPRs can cause. The processor writes the contents of the rename registers to the appropriate FPR when the completion unit retires floating-point instructions.

The processor supports all IEEE 754 floating-point data types (normalized, denormalized, NaN, zero, and infinity) in hardware, eliminating the latency that software exception routines incur.

5.2.4.3 Load/Store Unit (LSU)

The Load/Store Unit LSU executes all load and store instructions and provides the data transfer interface among the GPRs, FPRs, and the cache/memory subsystem. The LSU calculates effective addresses, performs data alignment, and provides sequencing for load/store string and multiple instructions.

Load and store instructions are issued and translated in program order. However, the actual memory accesses can occur out of order. Synchronizing instructions enforce strict ordering where needed.

Cacheable loads, when free of data dependencies, execute in an out-of-order manner with a maximum throughput of one per cycle and a two-cycle total latency. Data returned from the cache is held in a rename register until the completion logic commits the value to a GPR or FPR. Store operations do not occur until a predicted branch is resolved, remaining in the store queue until the completion logic signals that the store operation should definitely be completed to memory.

The processor core executes store instructions with a maximum throughput of one per cycle and a three-cycle total latency. The time required to perform the actual load or store operation varies depending on whether the operation involves the cache, system memory, or an I/O device.

5.2.4.4 System Register Unit (SRU)

The SRU executes various system-level instructions, including condition register logical operations and move to or from special-purpose register instructions and integer add/compare instructions. Because SRU instructions affect modes of processor operation, most SRU instructions are completion-serialized; the instruction is held for execution in the SRU until all prior instructions issued have completed. Results from completion-serialized instructions that the SRU executes are not available or forwarded for subsequent instructions until the instruction completes.

5.2.5 Completion Unit

The completion unit tracks instructions from dispatch through execution, and then retires or completes them in program order. Completing an instruction commits the processor core to any architectural register changes that the instruction caused. In-order completion ensures the correct architectural state when the processor core must recover from a mispredicted branch or any exception.

Instruction state and other information that is required for completion is kept in a first-in-first-out (FIFO) queue of five completion buffers. A single completion buffer is allocated for each instruction when it enters the dispatch unit. An available completion buffer is a required resource for instruction dispatch. If no completion buffers are available, instruction dispatch stalls. A maximum of two instructions per cycle are completed in order from the queue.

5.2.6 Memory Subsystem Support

The processor core supports cache and memory management through separate instruction and data MMUs (IMMU and DMMU). The processor core also provides dual 16-Kbyte

instruction and data caches and an efficient peripheral bus interface to facilitate access to main memory and other bus subsystems. The memory subsystem support functions are described in the following subsections.

5.2.6.1 Memory Management Units (MMUs)

The processor core's MMUs support up to 4 Petabytes (2^{52}) of virtual memory and 4 Gbytes (2^{32}) of physical memory (called *real memory* in the PowerPC architecture specification) for instructions and data. The MMUs also control access privileges for these spaces on block and page granularities. Referenced and changed status is maintained by the processor for each page to assist implementation of a demand-paged virtual memory system. A key bit is implemented to provide information about memory protection violations before page table search operations.

The LSU calculates effective addresses for data loads and stores, performs data alignment to and from cache memory, and provides the sequencing for load and store string and multiple word instructions. The instruction unit calculates the effective addresses for instruction fetching.

The MMUs translate effective addresses and enforce the protection hierarchy programmed by the operating system in relation to the supervisor/user privilege level of the access and in relation to the type of access—load or store.

5.2.6.2 Cache Units

The processor core provides independent 16-Kbyte, four-way set-associative instruction and data caches. The cache block size is 32 bytes. The caches are designed to adhere to a write-back policy, but the processor core allows control of cacheability, write policy, and memory coherency at the page and block levels. The caches use a least recently used (LRU) replacement algorithm.

The load/store and instruction fetch units provide the caches with the address of the data or instruction to be fetched. In the case of a cache hit, the cache returns two words to the requesting unit.

Note that the MPC8245 processor core has some additional cache locking functionality compared to the MPC603e (see more detail in Section 5.4.2.3, "Cache Locking".

5.2.6.3 Peripheral Logic Bus Interface

The MPC8245 contains an internal peripheral logic bus that interfaces the processor core to the peripheral logic. This internal bus is very similar in function to the external 60x bus interface on the MPC603e. In the case of the MPC8245, the central control unit (CCU) terminates all transactions and internally directs all accesses to the appropriate peripheral (or memory) interface.

5.2.6.3.1 Peripheral Logic Bus Protocol

The processor core-to-peripheral logic interface includes a 32-bit address bus, a 32- or 64-bit data bus, and control and information signals. The peripheral logic interface allows for address-only transactions as well as address and data transactions. The processor core control and information signals include the following:

- Address arbitration
- Address start
- Address transfer
- Transfer attribute
- Address termination
- Data arbitration
- Data transfer
- Data termination
- Processor state signals

Test and control signals provide diagnostics for selected internal circuits.

The peripheral logic interface supports bus pipelining, which allows the address tenure of one transaction to overlap the data tenure of another. The peripheral logic bus monitors PCI accesses to the memory space to allow the processor to snoop these accesses (provided PICR[27] is cleared).

5.2.6.3.2 Peripheral Logic Bus Data Transfers

As part of the peripheral logic bus interface, the processor core's data bus is configured at power-up (by the value on the MDL[0] signal) to either a 32- or 64-bit width.

When the processor is configured with a 32-bit data bus, memory accesses on the peripheral logic bus interface allow transfer sizes of 8, 16, 24, or 32 bits in one bus clock cycle. Data transfers occur in either single-beat transactions or two- or eight-beat burst transactions, with a single-beat transaction transferring as many as 32 bits. Single- or double-beat transactions are caused by noncached accesses that access memory directly (that is, reads and writes when caching is disabled, caching-inhibited accesses, and stores in write-through mode). Eight-beat burst transactions, which always transfer an entire cache line (32 bytes), are initiated when a line is read from or written to memory.

When the peripheral logic bus interface is configured with a 64-bit data bus, memory accesses allow transfer sizes of 8, 16, 24, 32, or 64 bits in one bus clock cycle. Data transfers occur in either single-beat transactions or four-beat burst transactions. Single-beat transactions are caused by noncached accesses that access memory directly (that is, reads and writes when caching is disabled, caching-inhibited accesses, and stores in

write-through mode). Four-beat burst transactions, which always transfer an entire cache line (32 bytes), are initiated when a line is read from or written to memory.

5.2.6.3.3 Peripheral Logic Bus Frequency

The core can operate at a variety of frequencies, allowing the designer to trade off performance for power consumption. The processor core is clocked from a separate PLL that is referenced to the peripheral logic PLL to allow the microprocessor and the peripheral logic to operate at different frequencies while maintaining a synchronous bus interface.

5.3 Programming Model

The following sections describe the PowerPC instruction set and addressing modes in general.

5.3.1 Register Set

This section describes the register organization in the processor core as defined by the three programming environments of the PowerPC architecture—the user instruction set architecture (UISA), the virtual environment architecture (VEA), and the operating environment architecture (OEA), as well as the MPC8245 core implementation-specific registers. Full descriptions of the basic register set that the PowerPC architecture defines are provided in Chapter 2, “PowerPC Register Set,” in *The Programming Environments Manual*.

The PowerPC architecture defines register-to-register operations for all computational instructions. Source data for these instructions is accessed from the on-chip registers or is provided as an immediate value embedded in the opcode. The three-register instruction format allows specification of a target register distinct from the two source registers, preserving the original data for use by other instructions and reducing the number of instructions that certain operations require. Data is transferred between memory and registers with explicit load and store instructions only.

Figure 5-2 shows the complete MPC8245 register set and programming environment for each register. Figure 5-2 includes both the PowerPC register set and the MPC8245-specific registers.

Note that there may be registers common to other processors that implement the PowerPC architecture that are not implemented in the MPC8245 processor core. Unsupported special purpose register (SPR) values are treated as follows:

- Any **mtspr** with an invalid SPR executes as a no-op.
- Any **mfspr** with an invalid SPR causes boundedly undefined results in the target register.

Conversely, some SPRs in the processor core may not be implemented at all or may not be implemented in the same way in other processors that implement the PowerPC architecture.

5.3.1.1 PowerPC Register Set

Either user- or supervisor-level instructions can access the PowerPC UISA registers, shown in Figure 5-2. The general-purpose registers (GPRs) and floating-point registers (FPRs) are accessed through instruction operands. Access to registers can be *explicit* (that is, through the use of specific instructions for that purpose, such as the **mtspr** and **mfspr** instructions) or *implicit* as part of the execution (or side effect) of an instruction. Some registers are accessed both explicitly and implicitly.

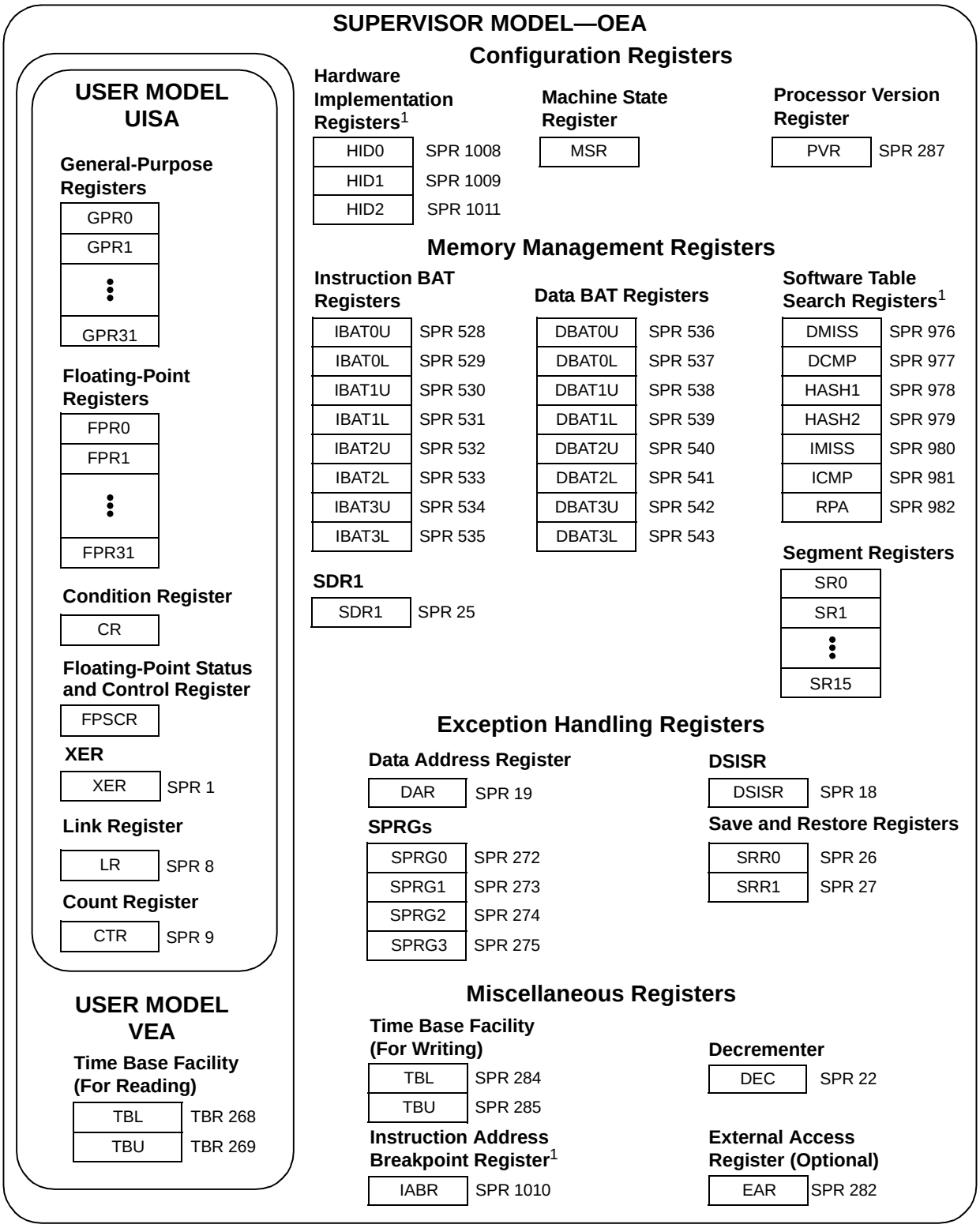
The number to the right of the register name indicates the number that is used in the syntax of the instruction operands to access the register (for example, the number used to access the XER is one). For more information about the PowerPC register set, refer to Chapter 2, “PowerPC Register Set,” in *The Programming Environments Manual*.

5.3.1.2 MPC8245-Specific Registers

The set of registers that is specific to the MPC603e is shown in Figure 5-2. Most of these are described in the *MPC603e RISC Microprocessor User’s Manual* and are implemented in the MPC8245 as follows:

- MMU software table search registers—DMISS, DCMP, HASH1, HASH2, IMISS, ICMP, and RPA. These registers facilitate the software required to search the page tables in memory.
- IABR—This register facilitates the setting of instruction breakpoints.

The hardware implementation-dependent registers (HIDx) are implemented differently in the MPC8245, as the following section describes.



[1] These implementation–specific registers may not be supported by other PowerPC processors or processor cores.

Figure 5-2. MPC8245 Programming Model—Registers

5.3.1.2.1 Hardware Implementation-Dependent Register 0 (HID0)

The processor core's implementation of HID0 differs from the *MPC603e RISC Microprocessor User's Manual* as follows:

- Bit 5, HID0[EICE], was removed.
- Pipeline tracking is not supported.

Figure 5-3 shows the MPC8245 implementation of HID0. HID0 can be accessed with **mtspr** and **mfspr** using SPR1008.

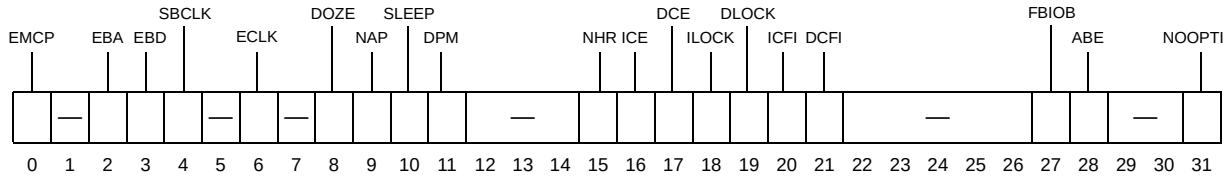


Figure 5-3. Hardware Implementation Register 0 (HID0)

Table 5-1 shows the bit definitions for HID0.

Table 5-1. HID0 Field Descriptions

Bits	Name	Description
0	EMCP	Enable machine check internal signal 0 The assertion of the internal *mcp* signal from the peripheral logic does not cause a machine check exception. 1 Enables the machine check exception based on assertion of the internal $\overline{mcp}$ signal from the peripheral logic to the processor core. Note that the machine check exception is further affected by MSR[ME], which specifies whether the processor checkstops or continues processing.
1	—	Reserved
2	EBA	Enable/disable internal peripheral bus (60x bus) address parity checking 0 Prevents address parity checking 1 Allows a address parity error to cause a checkstop if MSR[ME] = 0, or a machine check exception if MSR[ME] = 1. EBA and EBD lets the processor operate with memory subsystems that do not generate parity.
3	EBD	Enable internal peripheral bus (60x bus) data parity checking 0 Parity checking is disabled 1 Allows a data parity error to cause a checkstop if MSR[ME] = 0, or a machine check exception if MSR[ME] = 1. EBA and EBD lets the processor operate with memory subsystems that do not generate parity.
4	SBCLK	CKO output enable and clock type selection. When PMCR1[CKO_SEL] = 0, this bit is used with HID0[ECLK] and the hard reset signals to configure CKO. See Table 5-3.
5	—	EICE bit on some other devices that implement the PowerPC architecture. This bit is not used in the MPC8245 (and so it is reserved).
6	ECLK	CKO output enable and clock type selection.When PMCR1[CKO_SEL] = 0, this bit is used in conjunction with HID0[SBCLK] and the hard reset signals to configure CKO. See Table 5-3.

Table 5-1. HID0 Field Descriptions (continued)

Bits	Name	Description
7	—	PAR bit on some other devices that implement the PowerPC architecture to disable precharge of ARTRY signal. This bit is not used in the MPC8245 (and so it is reserved).
8	DOZE	Doze mode enable. Operates in conjunction with MSR[POW]. [1] 0 Processor doze mode disabled 1 Processor doze mode enabled. Doze mode is invoked by setting MSR[POW] while this bit is set. In doze mode, the PLL, time base, and snooping remain active.
9	NAP	Nap mode enable—Operates in conjunction with MSR[POW] [1] 0 Processor nap mode disabled 1 Processor nap mode enabled. Nap mode is invoked by setting MSR[POW] while this bit is set. When this occurs, the processor indicates that it is ready to enter nap mode. If the peripheral logic determines that the processor may enter nap mode (no more snooping of the internal buffers is required), the processor enters nap mode after several processor clocks. In nap mode, the PLL and the time base remain active. Note that the MPC8245 asserts the QACK output signal depending on the power-saving state of the peripheral logic, and not on the power-saving state of the processor core.
10	SLEEP	Sleep mode enable—Operates in conjunction with MSR[POW] [1] 0 Processor sleep mode disabled 1 Processor sleep mode enabled—Sleep mode is invoked by setting MSR[POW] while this bit is set. When this occurs, the processor indicates that it is ready to enter sleep mode. If the peripheral logic determines that the processor may enter sleep mode (no more snooping of the internal buffers is required), the processor enters sleep mode after several processor clocks. At this point, the system logic may turn off the PLL by first configuring PLL_CFG[0–4] to PLL bypass mode, and then disabling the internal *sys_logic-clk* signal. Note that the MPC8245 asserts the QACK output signal depending on the power-saving state of the peripheral logic, and not on the power-saving state of the processor core.
11	DPM	Dynamic power management enable [1] 0 Processor dynamic power management is disabled 1 Functional units enter a low-power mode automatically if the unit is idle. This does not affect operational performance and is transparent to software or any external hardware.
12–14	—	Reserved
15	NHR	Not hard reset (software-use only)—Helps software distinguish a hard reset from a soft reset. 0 A hard reset occurred if software had previously set this bit. 1 A hard reset has not occurred. If software sets this bit after a hard reset, when a reset occurs and this bit remains set, software can detect that it was a soft reset.
16	ICE	Instruction cache enable [2] 0 The instruction cache is neither accessed nor updated. All pages are accessed as if they were marked cache-inhibited (WIM = X1X). Potential cache accesses from the bus (snoop and cache operations) are ignored. In the disabled state for the L1 caches, the cache tag state bits are ignored, and all accesses are propagated to the bus as single-beat transactions. For these transactions, however, the processor reflects the original state of the I bit (from the MMU) to the peripheral logic block, regardless of cache disabled status. ICE is zero at power-up. 1 The instruction cache is enabled

Table 5-1. HID0 Field Descriptions (continued)

Bits	Name	Description
17	DCE	Data cache enable [2] 0 The data cache is neither accessed nor updated. All pages are accessed as if they were marked cache-inhibited (WIM = X1X). Potential cache accesses from the bus (snoop and cache operations) are ignored. In the disabled state, the cache tag state bits are ignored and all accesses are propagated to the bus as single-beat transactions. For those transactions, however, the processor reflects the original state of the I bit (from the MMU) to the peripheral logic block, regardless of cache disabled status. DCE is zero at power-up. 1 The data cache is enabled
18	ILOCK	Instruction cache lock 0 Normal operation 1 Instruction cache is locked. A locked cache supplies data normally on a hit, but an access is treated as a cache-inhibited transaction on a miss. On a miss, the transaction to the bus is single-beat. To prevent locking during a cache access, an **isync** must precede the setting of ILOCK.
19	DLOCK	Data cache lock 0 Normal operation 1 Data cache is locked. A locked cache supplies data normally on a hit but an access is treated as a cache-inhibited transaction on a miss. On a miss, the transaction to the bus is single-beat. A snoop hit to a locked L1 data cache performs as if the cache were not locked. A cache block invalidated by a snoop remains invalid until the cache is unlocked. To prevent locking during a cache access, a sync must precede the setting of DLOCK.
20	ICFI	Instruction cache flash invalidate [2] 0 The instruction cache is not invalidated. The bit is cleared when the invalidation operation begins (usually the next cycle after the write operation to the register). The instruction cache must be enabled for the invalidation to occur. 1 An invalidate operation is issued that marks the state of each instruction cache block as invalid without writing back modified cache blocks to memory. Cache access is blocked during this time. Accesses to the cache from the peripheral logic bus are signaled as a miss during invalidate-all operations. Setting ICFI clears all the valid bits of the blocks and the PLRU bits to point to way L0 of each set. For MPC603e processors, the proper use of the ICFI and DCFI bits is to set them and clear them with two consecutive **mtspr** operations.
21	DCFI	Data cache flash invalidate [2] 0 The data cache is not invalidated. The bit is cleared when the invalidation operation begins (usually the next cycle after the write operation to the register). The data cache must be enabled for the invalidation to occur. 1 An invalidate operation is issued that marks the state of each data cache block as invalid without writing back modified cache blocks to memory. Cache access is blocked during this time. Accesses to the cache from the peripheral logic bus are signaled as a miss during invalidate-all operations. Setting DCFI clears all the valid bits of the blocks and the PLRU bits so that they point to way L0 of each set. For MPC603e processors, the proper use of the ICFI and DCFI bits is to set them and clear them with two consecutive **mtspr** operations.
22–23	—	Reserved
24	—	IFEM bit on some other devices that implement the PowerPC architecture This bit is not used in the MPC8245 (and so it is reserved)
25–26	—	Reserved

Table 5-1. HID0 Field Descriptions (continued)

Bits	Name	Description
27	FBIOB	Force branch indirect on bus 0 Register indirect branch targets are fetched normally 1 Forces register indirect branch targets to be fetched externally
28	ABE	Address broadcast enable—controls whether certain address-only operations (such as cache operations, **eieio**, and **sync**) are broadcast on the peripheral logic bus. 0 Address-only operations affect only local L1 caches and are not broadcast 1 Address-only operations are broadcast on the peripheral logic bus.Affected instructions are **eieio**, **sync**, **dcbi**, **dcbf**, and **dcbst**. A **sync** instruction completes only after a successful broadcast. Execution of **eieio** causes a broadcast that may be used to prevent the MPC8245 from store gathering. Note that **dcbz** (with M = 1, coherency required) always broadcasts on the peripheral logic bus regardless of the setting of this bit. An **icbi** is never broadcast. No cache operations, except **dcbz**, are snooped by the processor core regardless of whether ABE is set. Peripheral logic bus activity caused by these instructions results directly from performing the operation on the processor cache.
29–30	—	Reserved
31	NOOPTI	No-op the data cache touch instructions 0 The **dcbt** and **dcbtst** instructions are enabled 1 The **dcbt** and **dcbtst** instructions are no-oped globally

1 See Chapter 9, “Power Management,” of the *MPC603e RISC Microprocessor User’s Manual* for more information.

2 See Chapter 3, “Instruction and Data Cache Operation,” of the *MPC603e RISC Microprocessor User’s Manual* for more information.

Table 5-2 shows how HID0[SBCLK], HID0[ECLK], and the hard reset signals configure CKO when PMCR1[CKO_SEL] = 0. When PMCR1[CKO_SEL] = 1, the CKO_MODE field of PMCR1 determines the signal driven on CKO. Note that the initial value of PMCR1[CKO_SEL] is determined by the value on the $\overline{\text{AS}}$ signal at the negation of $\overline{\text{HRST_CPU}}$. See Section 2.2.8.8, “Debug Clock (CKO)—Output,” and Section 2.4, “Configuration Signals Sampled at Reset,” for more information.

Table 5-2. HID0[BCLK] and HID0[ECLK] CKO Signal Configuration

$\overline{\text{HRST_CPU}}$ and HRST_CTRL	HID0[ECLK]	HID0[SBCLK]	Signal Driven on CKO
Asserted	x	x	*sys-logic-clk*
Negated	0	0	High impedance
Negated	0	1	*sys-logic-clk* divided by 2
Negated	1	0	Processor core clock
Negated	1	1	sys-logic-clk

5.3.1.2.2 Hardware Implementation-Dependent Register 1 (HID1)

The MPC8245 implementation of HID1 is shown in Figure 5-4.

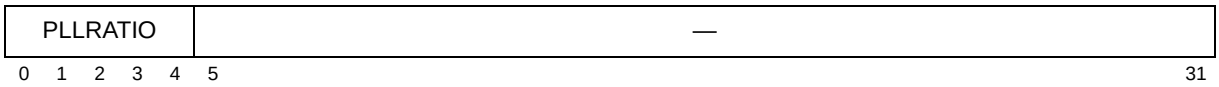


Figure 5-4. Hardware Implementation Register 1 (HID1)

Table 5-3 shows the bit definitions for HID1.

Table 5-3. HID1 Field Descriptions

Bits	Name	Function
0–4	PLLRATIO	PLL configuration processor core frequency ratio—This read-only field is determined by the value on the PLL_CFG[0–4] signals during reset and the processor-to-memory clock frequency ratio defined by that PLL_CFG[0–4] value. See *MPC8245 Integrated Processor Hardware Specifications* for a listing of supported settings. Note that multiple settings of the PLL_CFG[0–4] signals can map to the same PLLRATIO value. Thus, system software cannot read the PLLRATIO value and associate it with a unique PLL_CFG[0–4] value.
5–31	—	Reserved

5.3.1.2.3 Hardware Implementation-Dependent Register 2 (HID2)

The processor core implements an additional hardware implementation-dependent register as shown in Figure 5-5, (and is not described in the *MPC603e RISC Microprocessor User's Manual)*.

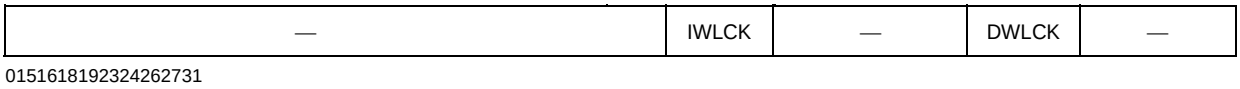


Figure 5-5. Hardware Implementation-Dependent Register 2 (HID2)

Table 5-4 describes the HID2 fields.

Table 5-4. HID2 Field Descriptions

Bits	Name	Function
0–15	—	Reserved
16–18	IWLCK	Instruction cache way lock—Useful for locking blocks of instructions into the instruction cache for time-critical applications where deterministic behavior is required. Refer to Section 5.4.2.3, "Cache Locking," for more information.
19–23	—	Reserved
24–26	DWLCK	Data cache way lock—Useful for locking blocks of data into the data cache for time-critical applications where deterministic behavior is required. Refer to Section 5.4.2.3, "Cache Locking," for more information.
27–31	—	Reserved

5.3.1.2.4 Processor Version Register (PVR)

Software can read the processor version register (PVR) to identify the MPC8245 processor core. The MPC8245 processor version number is 0x8081, and the processor revision level starts at 0x1014 and is incremented for each revision of the chip. This information is useful for data cache flushing routines for identifying the size of the cache and identifying this processor as one that supports cache locking.

5.3.2 PowerPC Instruction Set and Addressing Modes

All PowerPC instructions are encoded as single-word (32-bit) opcodes. Instruction formats are consistent among all instruction types, permitting efficient decoding to occur in parallel with operand accesses. This fixed instruction length and consistent format simplifies instruction pipelining.

5.3.2.1 Calculating Effective Addresses

The effective address (EA) is the 32-bit address that the processor computes when executing a memory access or branch instruction or when fetching the next sequential instruction.

The PowerPC architecture supports two simple memory addressing modes:

- EA = (**r**A|0) + offset (including offset = 0) (register indirect with immediate index)
- EA = (**r**A|0) +7 **r**B (register indirect with index)

These simple addressing modes allow efficient address generation for memory accesses. Calculation of the effective address for aligned transfers occurs in a single clock cycle.

For a memory access instruction, if the sum of the effective address and the operand length exceeds the maximum effective address, the memory operand is considered to wrap around from the maximum effective address to effective address 0.

Effective address computations for both data and instruction accesses use 32-bit unsigned binary arithmetic. A carry from bit 0 is ignored in 32-bit implementations.

In addition to the functionality of the MPC603e, the MPC8245 has more hardware support for misaligned little-endian accesses. Except for string/multiple load and store instructions, little-endian load/store accesses that are not on a word boundary generate exceptions under the same circumstances as big-endian requests.

5.3.2.2 PowerPC Instruction Set

PowerPC instructions are divided into the following categories:

- Integer instructions, which include computational and logical instructions

  - Integer arithmetic, which divide instructions execute with a shorter latency as described in Section 5.7, “Instruction Timing”
  - Integer compare
  - Integer logical
  - Integer rotate and shift
- Floating-point instructions, which include floating-point computational instructions and instructions that affect the FPSCR
  - Floating-point arithmetic
  - Floating-point multiply/add
  - Floating-point rounding and conversion
  - Floating-point compare
  - Floating-point status and control
- Load/store instruction, which include integer and floating-point load and store instructions
  - Integer load and store
  - Integer load and store with byte reverse
  - Integer load and store string/multiple
  - Floating-point load and store
- Flow control instructions, which include branching instructions, condition register logical instructions, trap instructions, and other synchronizing instructions that affect the instruction flow
  - Branch and trap
  - Condition register logical
  - Primitives used to construct atomic memory operations (**lwarx** and **stwcx**.)
  - Synchronize
- Processor control instructions, which synchronize memory accesses and manage caches, TLBs, and the segment registers.
  - Move to/from SPR
  - Move to/from MSR
  - Instruction synchronize
- Memory control instructions, which control caches, TLBs, and segment registers
  - Supervisor-level cache management
  - User-level cache management
  - Segment register manipulation
  - TLB management

Note that this grouping of the instructions does not indicate which execution unit executes a particular instruction or group of instructions.

Integer instructions operate on byte, half word, and word operands. The PowerPC architecture uses instructions that are four bytes long and word-aligned. PowerPC provides for byte, half-word, and word operand loads and stores between memory and a set of 32 GPRs. Floating-point instructions operate on single-precision (one word) and double-precision (one double-word) floating-point operands. PowerPC also provides for word and double-word operand loads and stores between memory and a set of 32 floating-point registers (FPRs).

Computational instructions do not modify memory. To use a memory operand in a computation and then modify the same or another memory location, the memory contents must be loaded into a register, modified, and written back to the target location with separate instructions. Decoupling computational instructions from memory accesses increases throughput by facilitating pipelining.

Processors that implement the PowerPC architecture follow the program flow when they are in the normal execution state. However, execution of an instruction or an asynchronous event can interrupt the flow of instructions directly. Either kind of exception may invoke one of several components of the system software.

5.3.2.3 MPC8245 Implementation-Specific Instruction Set

The MPC8245 processor core instruction set is defined as follows:

- The processor core provides hardware support for all 32-bit PowerPC instructions.
- The processor core provides two implementation-specific instructions used for software table search operations following TLB misses:
  - Load Data TLB Entry (**tlbld**)
  - Load Instruction TLB Entry (**tlbli**)
- The processor core implements the following instructions that the PowerPC architecture defines as optional:
  - Floating Select (**fsel**)
  - Floating Reciprocal Estimate Single-Precision (**fres**)
  - Floating Reciprocal Square Root Estimate (**frsqrte**)
  - Store Floating-Point as Integer Word Indexed (**stfiwx**)
  - External Control In Word Indexed (**eciwx**)
  - External Control Out Word Indexed (**ecowx**)

The MPC8245 does not provide the hardware support for misaligned **eciwx** and **ecowx** instructions that the MPC603e processor provides. An alignment exception is taken if these instructions are not word-aligned.

5.4 Cache Implementation

The MPC8245 processor core has separate data and instruction caches. The cache implementation is described in the following sections.

5.4.1 PowerPC Cache Model

The PowerPC architecture does not define hardware aspects of cache implementations. For example, some processors that implement the PowerPC architecture, including the MPC8245 processor core, have separate instruction and data caches (for example, Harvard architecture).

Microprocessors that implement the PowerPC architecture control the following memory access modes on a page or block basis:

- Write-back/write-through mode
- Caching-inhibited mode
- Memory coherency

An application programmer can use the PowerPC cache management instructions to affect the cache contents.

5.4.2 MPC8245 Implementation-Specific Cache Implementation

As shown in Figure 5-1, the caches provide a 64-bit interface to the instruction fetch unit and load/store unit. The surrounding logic selects, organizes, and forwards the requested information to the requesting unit. Write operations to the cache can be performed on a byte basis, and a complete read-modify-write operation to the cache can occur in each cycle.

Each cache block contains eight contiguous words from memory that are loaded from an eight-word boundary (that is, bits A27–A31 of the effective addresses are zero) so that a cache block never crosses a page boundary. Misaligned accesses across a page boundary can incur a performance penalty.

The cache blocks are loaded in to the processor core in four beats of 64 bits each. The burst load is performed as critical double word first.

To ensure coherency among caches in a multiprocessor (or multiple caching-device) implementation, the processor core implements the modified, exclusive, and invalid (MEI) protocol. These three terms, modified, exclusive, and invalid, indicate the state of the cache block as follows:

- Modified—The cache block is modified with respect to system memory. Data for this address is valid only in the cache and not in system memory.

- Exclusive—This cache block holds valid data that is identical to the data at this address in system memory. No other cache has this data.
- Invalid—This cache block does not hold valid data.

5.4.2.1 Data Cache

As shown in Figure 5-6, the data cache is configured as 128 sets of four blocks each. Each block consists of 32 bytes, two state bits, and an address tag. The two state bits implement the three-state MEI (modified/exclusive/invalid) protocol. Each block contains eight 32-bit words. Note that the PowerPC architecture defines the term ‘block’ as the cacheable unit. For the MPC8245 processor core, the block size is equivalent to a cache line.

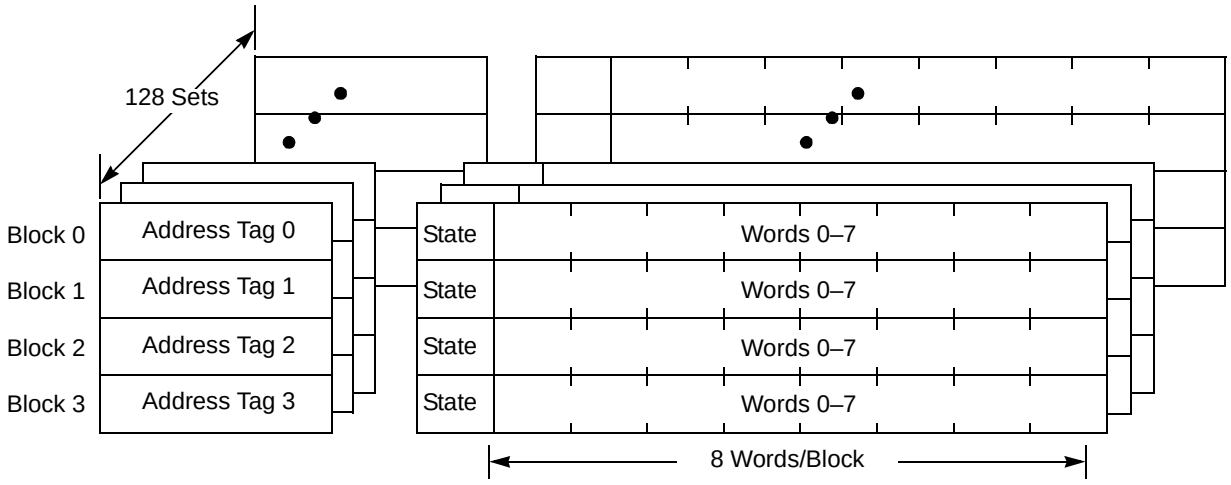


Figure 5-6. Data Cache Organization

Because the processor core data cache tags are single-ported, simultaneous load or store and snoop accesses cause resource contention. Snoop accesses have the highest priority and are given first access to the tags, unless the snoop access coincides with a tag write. In that case, the snoop is retried and must rearbitrate for access to the cache. Loads or stores that snoop accesses defer are executed on the clock cycle following the snoop.

Because the caches on the processor core are write-back caches, the predominant type of transaction to the memory subsystem for most applications is burst-read memory operations, followed by burst-write memory operations, and single-beat (noncacheable or write-through) memory read and write operations. When a cache block is filled with a burst read, the critical double word is simultaneously written to the cache and forwarded to the requesting unit to minimize stalls that load delays cause.

Additionally, there can be address-only operations, variants of the burst and single-beat operations, (for example, global memory operations that are snooped and atomic memory operations), and address retry activity (for example, when a snooped read access hits a

modified line in the cache). Note that all memory subsystem references are performed by the processor core to the internal peripheral logic bus on the MC8240.

The address and data buses of the internal peripheral logic bus operate independently to support pipelining and split transactions during memory accesses. The processor core pipelines its own transactions to a depth of one level.

Typically, memory accesses are weakly ordered. Sequences of operations, including load/store string and multiple instructions, do not necessarily complete in the order they begin to maximize the efficiency of the internal bus without sacrificing coherency of the data. The processor core allows pending read operations to precede previous store operations (except when a dependency exists, or in cases where a noncacheable access is performed), and provides support for a write operation to proceed a previously queued read data tenure (for example, allowing a snoop push to be enveloped by the address and data tenures of a read operation). Because the processor can dynamically optimize run-time ordering of load/store traffic, overall performance is improved.

5.4.2.2 Instruction Cache

The instruction cache also consists of 128 sets of 4 blocks—each block consists of 32 bytes, an address tag, and a valid bit. The instruction cache may not be written to except through a block fill operation caused by a cache miss. In the processor core, internal access to the instruction cache is blocked only until the critical load completes.

The processor core supports instruction fetching from other instruction cache lines following the forwarding of the critical first double-word of a cache line load operation. The processor core's instruction cache is blocked only until the critical load completes (hits under reloads allowed). Successive instruction fetches from the cache line being loaded are forwarded, and accesses to other instruction cache lines can proceed during the cache line load operation.

The instruction cache is not snooped, and cache coherency must be maintained by software. A fast hardware invalidation capability is provided to support cache maintenance. The organization of the instruction cache is very similar to the data cache shown in Figure 5-6.

5.4.2.3 Cache Locking

The processor core supports cache locking, which is the ability to prevent some or all of a microprocessor's instruction or data cache from being overwritten. Cache entries can be locked for either an entire cache or for individual ways within the cache. Entire data cache locking is enabled by setting HID0[DLOCK], and entire instruction cache locking is enabled by setting HID0[ILOCK]. For more information, refer to Motorola Application Note, *Cache Locking on the G2 Core* (order #: AN1767/D).The IWLCK and DWLCK bits of HID2 control cache way locking.

5.4.2.3.1 Entire Cache Locking

When an entire cache is locked, hits within the cache are supplied in the same manner as hits to an unlocked cache. Any access that misses in the cache is treated as a cache-inhibited access. Cache entries that are invalid at the time of locking remain invalid and inaccessible until the cache is unlocked. When the cache has been unlocked, all entries (including invalid entries) are available. Entire cache locking is inefficient if the number of instructions or the size of data to be locked is small compared to the cache size.

5.4.2.3.2 Way Locking

Locking only a portion of the cache is accomplished by locking ways within the cache. Locking always begins with the first way (way0) and is sequential. That is, it is valid to lock ways 0, 1, and 2, but it is not possible to lock just way0 and way2. When using way locking at least one way must be left unlocked. The maximum number of lockable ways is three.

Unlike entire cache locking, invalid entries in a locked way are accessible and available for data placement. As hits to the cache fill invalid entries within a locked way, the entries become valid and locked. This behavior differs from entire cache locking where nothing is placed in the cache, even if invalid entries exist in the cache. Unlocked ways of the cache behave normally.

5.4.3 Cache Coherency

The central control unit (CCU) manages the cache coherency within the MPC8245. It responds to all accesses generated by the processor core and causes the snooping of the addresses in the internal buffers as necessary. Also, the CCU generates snoop transactions on the peripheral logic bus to allow the processor to snoop accesses between the PCI interface and memory. Refer to Chapter 7, “PCI Bus Interface,” for more detailed information about the internal address and data buffers in the MPC8245.

5.4.3.1 CCU Responses to Processor Transactions

The processor core generates various types of read and write accesses as well as address-only transactions. Table 5-5 shows all the types of internal transactions that the processor core and the CCU responses perform.

Table 5-5. CCU Responses to Processor Transactions

Processor Transaction	CCU Response
Read	Directs read to appropriate interface
Read-with-intent-to-modify	
Read atomic	
Read-with-intent-to-modify-atomic	
Write-with-flush	
Write-with-kill	
Write-with-flush-atomic	
sync (if HID0[ABE] = 1)	CCU buffers flushed
eieio (if HID0[ABE] = 1)	CCU buffers flushed
Kill block (generated by **dcbz** instruction when the addressed block has either the E or M bits set)	CCU buffers snooped
icbi	CCU buffers snooped
Read-with-no-intent-to-cache	Directs read to appropriate interface
Clean	CCU takes no further action.
Flush	CCU takes no further action.
tlbie	CCU takes no further action.
lwarx, reservation set	CCU takes no further action. (The MPC8245 does not support atomic references in PCI memory space.)
stwcx., reservation set	CCU takes no further action. (The MPC8245 does not support atomic references in PCI memory space.)
tlbsync	CCU takes no further action.
Graphic write (ecowx)	Processor transaction error. Machine check signalled to processor core (if enabled).
Graphic read (eciwx)	Processor transaction error. Machine check signalled to processor core (if enabled).

5.4.3.2 Processor Responses to PCI-to-Memory Transactions

The CCU controls the data flow between the PCI interface and the memory interface. One of its functions is to broadcast these transactions on the peripheral logic bus so that the processor core can snoop the L1 cache as needed (if snooping is enabled). Table 5-6 shows all the types of transactions that the CCU reflects to the processor core for snooping.

Table 5-6. Transactions Reflected to the Processor for Snooping

Snooped Transaction	Condition Detected by CCU	Processor Response
Read	Non-locked PCI read from memory	All burst reads observed on the bus are snooped as if they were writes, causing the addressed cache block to be flushed. A read marked as global causes the following responses: • If the addressed block in the cache is invalid, the processor takes no action. • If the addressed block in the cache is in the exclusive state, the block is invalidated. • If the addressed block in the cache is in the modified state, the block is flushed to memory and the block is invalidated.
Read-with-intent-to-modify (RWITM)-atomic	Locked PCI read from memory	A RWITM operation is issued to acquire exclusive use of a memory location for the purpose of modifying it. • If the addressed block is invalid, the processor takes no action. • If the addressed block in the cache is in the exclusive state, the processor changes the state of the cache block to invalid. • If the addressed block in the cache is in the modified state, the block is flushed to memory and the block is invalidated.
Write-with-flush Write-with-flush-atomic	Non-locked PCI write to memory or locked PCI write to memory, respectively	• If the addressed block is in the exclusive state, the snoop forces the state of the addressed block to invalid. • If the addressed block is in the modified state, the snoop causes a push of the modified block out of the cache to memory and changes the state of the block to invalid.
Write-with-kill	Locked or non-locked PCI write with invalidate to memory	In a write-with-kill operation, the processor snoops the cache for a copy of the addressed block. If one is found the cache block is forced to the I state, killing modified data that may have been in the block.

5.5 Exception Model

This section describes the PowerPC exception model and implementation-specific details of the MPC8245 core.

5.5.1 PowerPC Exception Model

The PowerPC exception mechanism allows the processor to change to supervisor state as a result of external signals, errors, or unusual conditions arising in the execution of instructions. When exceptions occur, information about the state of the processor is saved to certain registers and the processor begins execution at an address (exception vector) predetermined for each exception. Processing of exceptions occurs in supervisor mode.

Although multiple exception conditions can map to a single exception vector, a more specific condition may be determined by examining a register associated with the exception. For example, the DSISR identifies instructions that cause a DSI exception. Additionally, software explicitly enables or disables some exception conditions.

PowerPC architecture requires that exceptions are handled in program order. Although a particular implementation may recognize exception conditions that are out of order, exceptions are taken in strict order. When an instruction-caused exception is recognized, any unexecuted instructions that appear earlier in the instruction stream, including any that have not yet entered the execute stage, must complete before the exception is taken. Any exceptions caused by those instructions are handled first. Likewise, exceptions that are asynchronous and precise are recognized when they occur, but are not handled until the instruction currently in the completion stage successfully completes execution or generates an exception, and the completed store queue is emptied.

Unless a catastrophic condition causes a system reset or machine check exception, only one exception is handled at a time. If, for example, a single instruction encounters multiple exception conditions, those conditions are handled sequentially. After the exception handler handles an exception, the instruction execution continues until the next exception condition is encountered. However, in many cases there is no attempt to re-execute the instruction. This method of recognizing and handling exception conditions sequentially guarantees that exceptions are recoverable.

5.5.1.1 Exceptions and Exception Handlers

Exception handlers should save the information stored in SRR0 and SRR1 early to prevent the program state from being lost due to a system reset or machine check exception or to an instruction-caused exception in the exception handler. SRR0 and SRR1 should also be saved before enabling external interrupts.

The PowerPC architecture supports the following four types of exceptions:

- Synchronous, precise exceptions are caused by instructions. All instruction-caused exceptions are handled precisely: the machine state at the time the exception occurs is known and can be completely restored. Except for trap and system call exceptions, the address of the faulting instruction is provided to the exception handler and neither the faulting instruction nor subsequent instructions in the code stream complete execution before the exception is taken. When the exception is processed, execution resumes at the address of the faulting instruction (or at an alternate address that the exception handler provides). When an exception is taken due to a trap or system call instruction, execution resumes at an address that the handler provides.
- Synchronous, imprecise—The PowerPC architecture defines two imprecise floating-point exception modes, recoverable and nonrecoverable, which are not implemented on the MPC8245.
- Asynchronous, maskable—The external interrupt ($\overline{int}$), system management interrupt ($\overline{SMI}$), and decrementer interrupts are maskable asynchronous exceptions. When these exceptions occur, their handling is postponed until the next instruction and any exceptions associated with that instruction complete execution. If no instructions are in the execution units, the exception is taken immediately on determination of the correct restart address (for loading SRR0).
- Asynchronous, nonmaskable—Two nonmaskable asynchronous exceptions are system reset and the machine check exception. These exceptions may not be recoverable, or may provide a limited degree of recoverability. All exceptions report recoverability through MSR[RI].

5.5.2 MPC8245 Implementation-Specific Exception Model

As specified by the PowerPC architecture, all processor core exceptions can be described as either precise or imprecise and either synchronous or asynchronous. Asynchronous exceptions (some of which are maskable) are caused by events external to the processor's execution. Synchronous exceptions, which are all handled precisely by the processor core, are caused by instructions. The processor core exception classes are shown in Table 5-7.

Table 5-7. Exception Classifications for the Processor Core

Synchronous/Asynchronous	Precise/Imprecise	Exception Type
Asynchronous, nonmaskable	Imprecise	Machine check System reset
Asynchronous, maskable	Precise	External interrupt Decrementer System management interrupt
Synchronous	Precise	Instruction-caused exceptions

Although exceptions have other characteristics (such as whether they are maskable or nonmaskable), the distinctions shown in Table 5-7 define categories of exceptions that the processor core handles uniquely. Note that Table 5-7 includes no synchronous imprecise instructions.

Note that the physical address of the hard reset vector is always 0xFFF0_0100. The exceptions are vectored to the physical address 0xFFF*n_nnnn* or 0x000*n_nnnn* depends on the setting of MSR[IP] where the default is 0xFFF*n_nnnn*.

Table 5-8 lists the processor core's exceptions and conditions that cause them.

Table 5-8. Exceptions and Conditions

Exception Type	Vector Offset (hex)	Causing Conditions
Reserved	00000	—
System reset	00100	A system reset is caused by the assertion of $\overline{\text{HRST_CPU}}$, $\overline{\text{SRESET}}$, or $\overline{\textit{sreset}}$ (asserted by the PIC unit).
Machine check	00200	A machine check exception is caused by the assertion of the NMI input signal or the occurrence of internal errors as described in Chapter 14, "Error Handling." This exception occurs when a machine check condition is detected, the error is enabled, HID0[EMCP] is set, PICR1[MCP_EN] is set, and MSR[ME] is set. When one of these errors occurs, the MPC8245 takes the exception and asserts the $\overline{\text{MCP}}$ output signal.
DSI	00300	The cause of a DSI exception can be determined by the DSISR bit settings, listed as follows: 1 Set if the translation of an attempted access is not found in the primary hash table entry group (HTEG), in the rehashed secondary HTEG, or in the range of a DBAT register; otherwise cleared. 4 Set if a memory access is not permitted by the page or DBAT protection mechanism; otherwise cleared. 5 Set by an **eciwx** or **ecowx** instruction if the access is to an address that is marked as write-through or execution of a load/store instruction that accesses a direct-store segment. 6 Set for a store operation and cleared for a load operation 11 Set if **eciwx** or **ecowx** is used and EAR[E] is cleared
ISI	00400	An ISI exception is caused when an instruction fetch cannot be performed for any of the following reasons: • The effective (logical) address cannot be translated. That is, there is a page fault for this portion of the translation, so an ISI exception must be taken to load the PTE (and possibly the page) into memory. • The fetch access is to a direct-store segment (indicated by SRR1[3] set). • The fetch access violates memory protection (indicated by SRR1[4] set). If the key bits (Ks and Kp) in the segment register and the PP bits in the PTE are set to prohibit read access, instructions cannot be fetched from this location.
External interrupt	00500	An external interrupt is caused when MSR[EE] = 1 and the internal $\overline{\textit{int}}$ signal is asserted by the PIC interrupt module to the processor core.

Table 5-8. Exceptions and Conditions (continued)

Exception Type	Vector Offset (hex)	Causing Conditions
Alignment	00600	An alignment exception is caused when the processor core cannot perform a memory access for any of the reasons described below: • The operand of a floating-point load or store is to a direct-store segment. • The operand of a floating-point load or store is not word-aligned. • The operand of a **lmw**, **stmw**, **lwarx**, or **stwcx**. is not word-aligned. • The operand of an elementary, multiple or string load or store crosses a segment boundary with a change to the direct store T bit. • The operand of **dcbz** instruction is in memory that is write-through required or caching inhibited, or **dcbz** is executed in an implementation that has either no data cache or a write-through data cache. • A misaligned **eciwx** or **ecowx** instruction • A multiple or string access with MSR[LE] set The processor core differs from MPC603e in that it initiates an alignment exception when it detects a misaligned **eciwx** or **ecowx** instruction and does not initiate an alignment exception when a little-endian access is misaligned.
Program	00700	A program exception is caused by one of the following exception conditions, which correspond to bit settings in SRR1 and arise during execution of an instruction: • Illegal instruction—An illegal instruction program exception is generated when execution of an instruction is attempted with an illegal opcode or illegal combination of opcode and extended opcode fields (including PowerPC instructions not implemented in the processor core), or when execution of an optional instruction not provided in the processor core is attempted (these do not include those optional instructions that are treated as no-ops). • Privileged instruction—A privileged instruction type program exception is generated when the execution of a privileged instruction is attempted and the MSR register user privilege bit, MSR[PR], is set. In the processor core, this exception is generated for **mtspr** or **mfspr** with an invalid SPR field if SPR[0] = 1 and MSR[PR] = 1. This may not be true for all processors that implement the PowerPC architecture. • Trap—A trap type program exception is generated when any of the conditions specified in a trap instruction are met.
Floating-point unavailable	00800	A floating-point unavailable exception is caused by an attempt to execute a floating-point instruction (including floating-point load, store, and move instructions) when the floating-point available bit is cleared (MSR[FP] = 0).
Decrementer	00900	The decrementer exception occurs when the most significant bit of the decrementer (DEC) register transitions from 0 to 1. Must also be enabled with the MSR[EE] bit.
Reserved	00A00–00BFF	—
System call	00C00	A system call exception occurs when a System Call (**sc**) instruction is executed.
Trace	00D00	A trace exception is taken when MSR[SE] = 1 or when the currently completing instruction is a branch and MSR[BE] = 1.
Floating-point assist	00E00	The MPC8420 does not generate an exception to this vector. Other processors that implement the PowerPC architecture may use this vector for floating-point assist exceptions.
Reserved	00E10–00FFF	—

Table 5-8. Exceptions and Conditions (continued)

Exception Type	Vector Offset (hex)	Causing Conditions
Instruction translation miss	01000	An instruction translation miss exception is caused when the effective address for an instruction fetch cannot be translated by the ITLB.
Data load translation miss	01100	A data load translation miss exception is caused when the effective address for a data load operation cannot be translated by the DTLB.
Data store translation miss	01200	A data store translation miss exception is caused when the effective address for a data store operation cannot be translated by the DTLB, or when a DTLB hit occurs, and the changed bit in the PTE must be set due to a data store operation.
Instruction address breakpoint	01300	An instruction address breakpoint exception occurs when the address (bits 0–29) in the IABR matches the next instruction to complete in the completion unit, and the IABR enable bit (bit 30) is set.
System management interrupt	01400	A system management interrupt is caused when MSR[EE] = 1 and the $\overline{\text{SMI}}$ input signal is asserted.
Reserved	01500–02FFF	—

5.5.3 Exception Priorities

The exception priorities for the processor core are unchanged from those described in the *MPC603e RISC Microprocessor User's Manual*, except for the alignment exception, whose causes are prioritized as follows:

1. The floating-point operand is not word-aligned.
2. The **lmw**, **stmw**, **lwarx**, or **stwcx** operands are not word-aligned.
3. The **eciwx** or **ecowx** operand is misaligned.
4. A multiple or string access is attempted with MSR[LE] set.

Also, a priority mechanism for all the conditions that are specific to the MPC8245 can cause a machine check exception (see Chapter 14, "Error Handling").

5.6 Memory Management

The following sections describe the memory management features of the PowerPC architecture and the MPC8245 implementation.

5.6.1 PowerPC MMU Model

The primary functions of the MMU are the following:

- To translate logical (effective) addresses to physical addresses for memory accesses
- To provide access protection on blocks and pages of memory

Two types of accesses that the processor core generates that require address translation are instruction accesses and data accesses to memory that load and store instructions generate.

The PowerPC MMU and exception models support demand-paged virtual memory. Virtual memory management permits execution of programs that are larger than the size of physical memory. Demand-paged implies that individual pages are loaded into physical memory from system memory only when they are first accessed by an executing program.

PowerPC architecture supports the following three translation methods:

- Address translations disabled. Translation is enabled by setting bits in the MSR—MSR[IR] enables instruction address translations and MSR[DR] enables data address translations. Clearing these bits disables translation and the effective address is used as the physical address.
- Block address translation. PowerPC architecture defines independent four-entry BAT arrays for instructions and data that maintain address translations for blocks of memory. Block sizes range from 128 Kbytes to 256 Mbytes and are software-selectable. System software maintains the BAT arrays. Figure 5-2 shows the BAT registers, which the PowerPC architecture defines for block address translations.
- Demand page mode. The page table contains a number of page table entry groups (PTEGs). A PTEG contains eight-page table entries (PTEs) of eight bytes each, making each PTEG 64 bytes long. PTEG addresses are entry points for table search operations.

  The hashed page table is a variable-sized data structure that defines the mapping between virtual page numbers and physical page numbers. The page table size is a power of two, its starting address is a multiple of its size.

  On-chip instruction and data TLBs provide address translation in parallel with the on-chip cache access, incurring no additional time penalty in the event of a TLB hit. A TLB is a cache of the most recently used page table entries. Software is responsible for maintaining the consistency of the TLB with memory. In the MPC8245, the processor core’s TLBs are 64-entry, two-way set-associative caches that contain instruction and data address translations. The MPC8245 core provides hardware assist for software table search operations through the hashed page table on TLB misses. Supervisor software can invalidate TLB entries selectively.

The MMU also directs the address translation and enforces the protection hierarchy that the operating system programs in relation to the supervisor/user privilege level of the access and in relation to whether the access is a load or store.

5.6.2 MPC8245 Implementation-Specific MMU Features

The instruction and data MMUs in the processor core provide four Gbytes of logical address space accessible to supervisor and user programs with a 4-Kbyte page size and 256-Mbyte segment size.

The MPC8245 MMUs support up to four Petabytes (2^{52}) of virtual memory and four Gbytes (2^{32}) of physical memory (called *real memory* in PowerPC architecture specification) for instructions and data. The processor maintains referenced and changed status for each page to assist implementation of a demand-paged virtual memory system.

The MPC8245 TLBs are 64-entry, two-way set-associative caches that contain instruction and data address translations. The processor core provides hardware assistance for software table search operations through the hashed page table on TLB misses. Supervisor software can invalidate TLB entries selectively.

After an effective address is generated, the higher-order bits of the effective address are translated by the appropriate MMU into physical address bits. Simultaneously, the lower-order address bits (that are untranslated, therefore, considered both logical and physical), are directed to the on-chip caches where they form the index into the four-way set-associative tag array. After translating the address, the MMU passes the higher-order bits of the physical address to the cache, and the cache lookup completes. For caching-inhibited accesses or accesses that miss in the cache, the untranslated lower-order address bits are concatenated with the translated higher-order address bits The system interface uses the resulting 32-bit physical address to external memory.

For instruction accesses, the MMU performs an address lookup in both the 64 entries of the ITLB and in the IBAT array. If an effective address hits in both the ITLB and the IBAT array, the IBAT array translation takes priority. Data accesses cause a lookup in the DTLB and DBAT array for the physical address translation. In most cases, the physical address translation resides in one of the TLBs and the physical address bits are readily available to the on-chip cache.

When the physical address translation misses in the TLBs, the processor core provides hardware assistance for software to search the translation tables in memory. When a required TLB entry is not found in the appropriate TLB, the processor vectors to one of the three TLB miss exception handlers so that the software can perform a table search operation and load the TLB. When this occurs, the processor automatically saves information about the access and the executing context. Refer to the *MPC603e RISC Microprocessor User's Manual* for more detailed information about these features and the suggested software routines for searching the page tables.

5.7 Instruction Timing

The processor core is a pipelined superscalar processor. A *pipelined processor* supports processing of an instruction that is broken into discrete stages, which implies that an instruction does not require the entire resources of an execution unit at one time. For example, after an instruction completes the decode stage, it can pass on to the next stage, while the subsequent instruction can advance into the decode stage to improve the throughput of instruction flow.

5.7.1 Stages of the Instruction Pipeline Processor

The instruction pipeline in the processor core includes four major stages, which the following subsections discuss.

5.7.1.1 Fetch Pipeline Stage

The fetch pipeline stage primarily involves retrieving instructions from the memory system and determining the location of the next instruction fetch. Additionally, the BPU decodes branches during the fetch stage and folds out branch instructions before the dispatch stage if possible.

5.7.1.2 Dispatch Pipeline Stage

The dispatch pipeline stage is responsible for decoding the instructions supplied by the instruction fetch stage and determining which instructions are eligible to be dispatched in the current cycle. In addition, the source operands of the instructions are read from the appropriate register file and dispatched with the instruction to the execute pipeline stage.

At the end of the dispatch pipeline stage, the dispatched instructions and their operands are latched by the appropriate execution unit.

5.7.1.3 Execute Pipeline Stage

During the execute pipeline stage, each execution unit that has an executable instruction executes the selected instruction (perhaps over multiple cycles), writes the instruction's result into the appropriate rename register and notifies the completion stage that the instruction finished executing. In the case of an internal exception, the execution unit reports the exception to the completion/writeback pipeline stage and discontinues instruction execution until the exception is handled. The exception is not signaled until that instruction is the next to be completed.

Execution of most load/store instructions is also pipelined. The load/store unit has two pipeline stages. The first stage is for effective address calculation and MMU translation, and the second stage is for accessing the data in the cache.

5.7.1.4 Complete/Writeback Pipeline Stage

The complete/writeback pipeline stage maintains the correct architectural machine state and transfers the contents of the rename registers to the GPRs and FPRs as instructions are retired. If the completion logic detects an instruction causing an exception, all following instructions are cancelled, their execution results in rename registers are discarded, and instructions are fetched from the correct instruction stream.

The processor core provides support for single-cycle store operations and provides an adder/comparator in the SRU that allows the dispatch and execution of multiple integer add and compare instructions on each cycle.

Performance of integer divide operations has been improved in the processor core. Execution of a divide instruction takes half the cycles to execute than that described in the *MPC603e RISC Microprocessor User's Manual*. The new latency is reflected in Table 5-9.

Table 5-9. Integer Divide Latency

Primary Opcode	Extended Opcode	Mnemonic	Form	Unit	Cycles
31	459	**divwu**[**o**][**.**]	xo	IU	20
31	491	**divw**[**o**][**.**]	xo	IU	20

5.8 Differences Between the MPC8245 Core and the MPC603e Processor

The MPC8245 processor core (G2 core) is a derivative of the MPC603e microprocessor design. Some changes were made and are visible either to a programmer or a system designer. Any software designed for an MPC603e is functional when replaced with the MPC8245 except for the specific changes listed in Table 5-10.

Software can distinguish between the MPC603e and the MPC8245 by reading the processor version register (PVR). The MPC8245 processor version number is 0x8081, the processor revision level starts at 0x1014 and is incremented for each revision of the chip. This information is most useful for programmers writing data cache flush routines.

Table 5-10. Major Differences Between the MPC8245 Core and the MPC603e

Description	Impact
Changed HID1 to add bus frequency multipliers as described in the *MPC8245 Integrated Processor Hardware Specifications*	On extra bit is provided for PLL configuration, and some other unused encodings of the PLL_CFG[0–4] are now defined.
Added hardware support for misaligned little-endian accesses	Except for strings/multiples, little-endian load/store accesses not on a word boundary generate exceptions under the same circumstances as big-endian accesses.
Removed misalignment support for **eciwx** and **ecowx** instructions.	These instructions cause an alignment exception if the operands are not on a word boundary.

Table 5-10. Major Differences Between the MPC8245 Core and the MPC603e

Description	Impact
Removed HID0[5]; now reserved	There is no support for ICE pipeline tracking.
Removed HID0[7]; now reserved	No impact, as the MPC8245 has no $\overline{\text{ARTRY}}$ signal.
Added instruction and data cache locking mechanism	Implements a cache way locking mechanism for both the instruction and data caches. One to three of the four ways in the cache can be locked with control bits in the HID2 register. See Section 5.3.1.2.3, “Hardware Implementation-Dependent Register 2 (HID2).”
Improved access to cache during block fills	The MPC8245 provides quicker access to incoming data and instruction on a cache block fill. See Section 5.4.2, “MPC8245 Implementation-Specific Cache Implementation.”
Improved integer divide latency	Performance of integer divide operations has been improved in the processor core. A divide takes half the cycles to execute as described in *MPC603e RISC Microprocessor User’s Manual*. The new latency is reflected in Table 5-9.
No support for **dcbz** instruction in areas of memory that are write-through and can be accessed by multiple logical addresses	This was previously documented as an anomaly in the MPC603e. Stores of zeros must be used instead of the **dcbz** instruction when the memory area is designated as write-through, coherency required.
Areas of memory accessed by **dcbz** instruction should not be marked as global	This was previously documented as an anomaly in the MPC603e. Areas of memory accessed by a **dcbz** instruction must be marked as not global in the BAT or PTE.

Chapter 6
Memory Interface

The MPC8245 integrates a high-performance memory controller that controls processor and PCI interactions to local memory. The MPC8245 supports various types of SDRAM and ROM/Flash configurations as local memory.

- SDRAM
  - — SDRAMs must comply with the JEDEC specification
  - — High-bandwidth bus (32- or 64-bit data bus) to SDRAM
  - — One-Mbyte to 2-Gbyte SDRAM memory: 1 to 8 chip selects for SDRAM bank sizes ranging from 1 Mbyte to 512 Mbytes per bank
  - — Supports page mode SDRAMs: four open pages simultaneously
  - — Programmable timing for SDRAMs
- ROM/Flash
  - — 272 Mbytes of base and extended ROM/Flash space
  - — Sixteen-Mbyte base ROM space can be divided between the PCI bus and the local memory bus
  - — Supports asynchronous ROM or burst-mode ROM
  - — Base ROM space supports 8-bit data path or same size as the SDRAM data path (32- or 64-bit)
  - — Extended ROM space supports 8-, 16-, 32-bit gathering data path or 64-/32-bit (wide) data path
  - — Supports bus-width writes to Flash
  - — Programmable timing
- Port X: The ROM/Flash controller can interface any device that can be controlled with an address and data field (communication devices, DSPs, general purpose I/O devices, or registers). Some devices may require a small amount of external logic to properly generate address strobes and chip selects.
  - — 8-, 16-, 32-, or 64-bit Port X. Note that the floating-point unit (FPU) must be enabled for 64-bit writes.
- Data-path buffering: 64 bits (64-bit data and 8-bit parity)

— Reduces loading on the internal processor core bus
— Reduces loading of the drivers of the memory system
— Reduces signal trace delay known as time-of-flight (TOF)

- Parity: Supports normal parity and read-modify-write (RMW)
- Error checking and correction (SDRAM ECC), 64-bit only. Located in-line with the data-path buffers.

The MPC8245 is designed to control a 32- or 64-bit data path to main memory (SDRAM). The MPC8245 can be configured to check parity or ECC on memory reads. Parity checking and generation can be enabled with 4 parity bits for a 32-bit data path or 8 parity bits for 64-bit data path. Concurrent ECC is generated only for 64-bit data path with 8 syndrome bits.

The MPC8245 supports SDRAM bank sizes from 1 to 512 Mbytes and provides bank start address and end address configuration registers.

The MPC8245 can be configured so that appropriate row and column address multiplexing occurs for each physical bank. Addresses and bank selects are provided through a 15-bit interface for SDRAM.

ROM/Flash systems are supported by up to 25 address bits, four bank selects, one write enable, and one output enable.

Figure 6-1 is a block diagram of the memory interface.

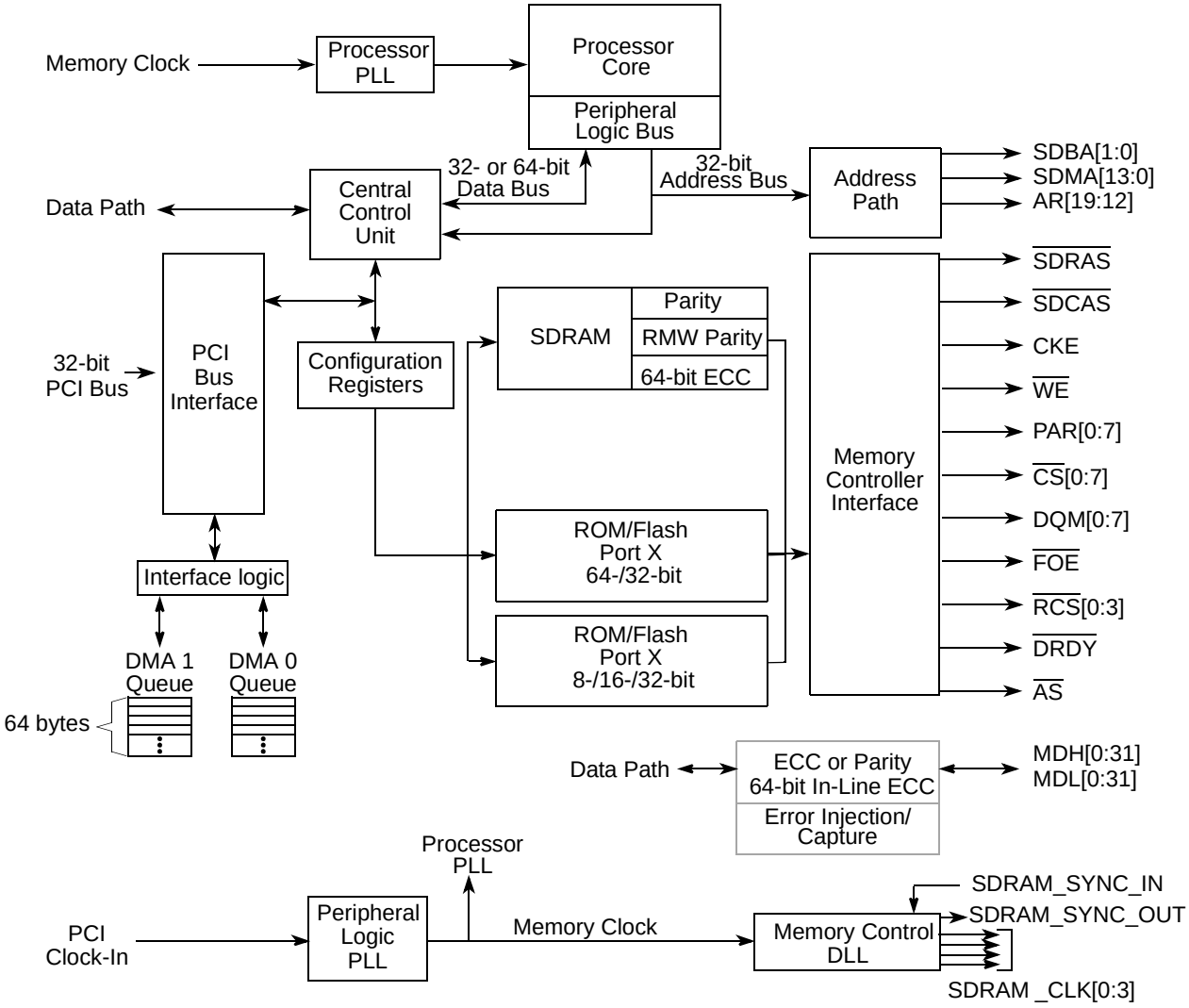


Figure 6-1. Block Diagram for Memory Interface

6.1 Memory Interface Signal Summary

Table 6-1 summarizes the memory interface signals. Some signals function differently, depending on the type of memory system the MPC8245 is configured to support.

Table 6-1. Memory Interface Signal Summary

Signal Name	Description	Alternate Function	Pins	I/O
$\overline{\text{CS}}$[0:7]	SDRAM chip select 0–7	—	8	O
DQM[0:7]	SDRAM data mask in/out 0–7	—	8	O
WE	Write enable	—	1	O

Table 6-1. Memory Interface Signal Summary (continued)

Signal Name	Description	Alternate Function	Pins	I/O
SDMA[14:13]	High order ROM address	See Table 6-2, "Memory Address Signal Mappings"	2	O
SDMA[12:0] [1]	SDRAM address 13–0		13	O
SDBA[1:0][1]	SDRAM bank select 1–0		2	O
MDH[0:31][1]	Data bus high	—	32	I/O
MDL[0:31][1]	Data bus low	—	32	I/O
PAR[0:7]	Data parity/ECC 0–7	AR[19:12]	8	I/O
AR[19:12]	ROM address 19–12	PAR[0:7]	8	O
CKE[1]	SDRAM clock enable	—	1	O
SDRAS	SDRAM row address strobe	—	1	O
SDCAS	SDRAM column address strobe	—	1	O
RCS[0:3][1]	ROM bank select 0–3	—	4	O
$\overline{\text{FOE}}$[1]	Flash output enable	—	1	O
$\overline{\text{AS}}$[1]	Address strobe for Port X	—	1	O
DRDY	Data ready for Port X strobe and handshake modes	—	1	I

1 The MPC8245 samples these signals at the negation of $\overline{\text{HRST_CTRL}}$ to determine the reset configuration. After they are sampled, they assume their normal functions. See Section 2.4, "Configuration Signals Sampled at Reset," for more information about their function during reset.

Table 6-2 shows memory address signal mappings.

Table 6-2. Memory Address Signal Mappings

MPC8245 Signal Name (Outputs)		Logical Names				JEDEC DIMM
		2-bank SDRAM Address	4-bank SDRAM Address	ROM/Flash Address 8-, 16-, and 32-bit Mode	ROM/Flash Address 64-bit Mode	SDRAM 168-pin DIMM Signals (Inputs)
msb	SDMA14			AR24		
	SDMA13			AR23	AR23	
	SDMA12		SDMA12	AR22	AR22	A12
	SDMA11		SDMA11	AR21	AR21	A11
	SDBA1	SDMA12	SDBA1	AR20	AR20	BA1 [1]
	PAR0			AR19	AR19	
	PAR1			AR18	AR18	
	PAR2			AR17	AR17	

Table 6-2. Memory Address Signal Mappings (continued)

MPC8245 Signal Name (Outputs)		Logical Names				JEDEC DIMM
		2-bank SDRAM Address	4-bank SDRAM Address	ROM/Flash Address 8-, 16-, and 32-bit Mode	ROM/Flash Address 64-bit Mode	SDRAM 168-pin DIMM Signals (Inputs)
	PAR3			AR16	AR16	
	PAR4			AR15	AR15	
	PAR5			AR14	AR14	
	PAR6			AR13	AR13	
	PAR7			AR12	AR12	
	SDBA0	SDBA0	SDBA0	AR11	AR11	BA0
	SDMA10	SDMA10	SDMA10	AR10	AR10	A10(AP)
	SDMA9	SDMA9	SDMA9	AR9	AR9	A9
	SDMA8	SDMA8	SDMA8	AR8	AR8	A8
	SDMA7	SDMA7	SDMA7	AR7	AR7	A7
	SDMA6	SDMA6	SDMA6	AR6	AR6	A6
	SDMA5	SDMA5	SDMA5	AR5	AR5	A5
	SDMA4	SDMA4	SDMA4	AR4	AR4	A4
	SDMA3	SDMA3	SDMA3	AR3	AR3	A3
	SDMA2	SDMA2	SDMA2	AR2	AR2	A2
	SDMA1	SDMA1	SDMA1	AR1	AR1	A1
lsb	SDMA0	SDMA0	SDMA0	AR0	AR0	A0

1 When upgrading from an MPC8240 system, BA1 on SDRAM DIMM will already be connected to SDRAM12 if 13xnx2 configurations were used.

6.2 SDRAM Interface Operation

Figure 6-2 shows an internal block diagram of the SDRAM interface of the MPC8245.

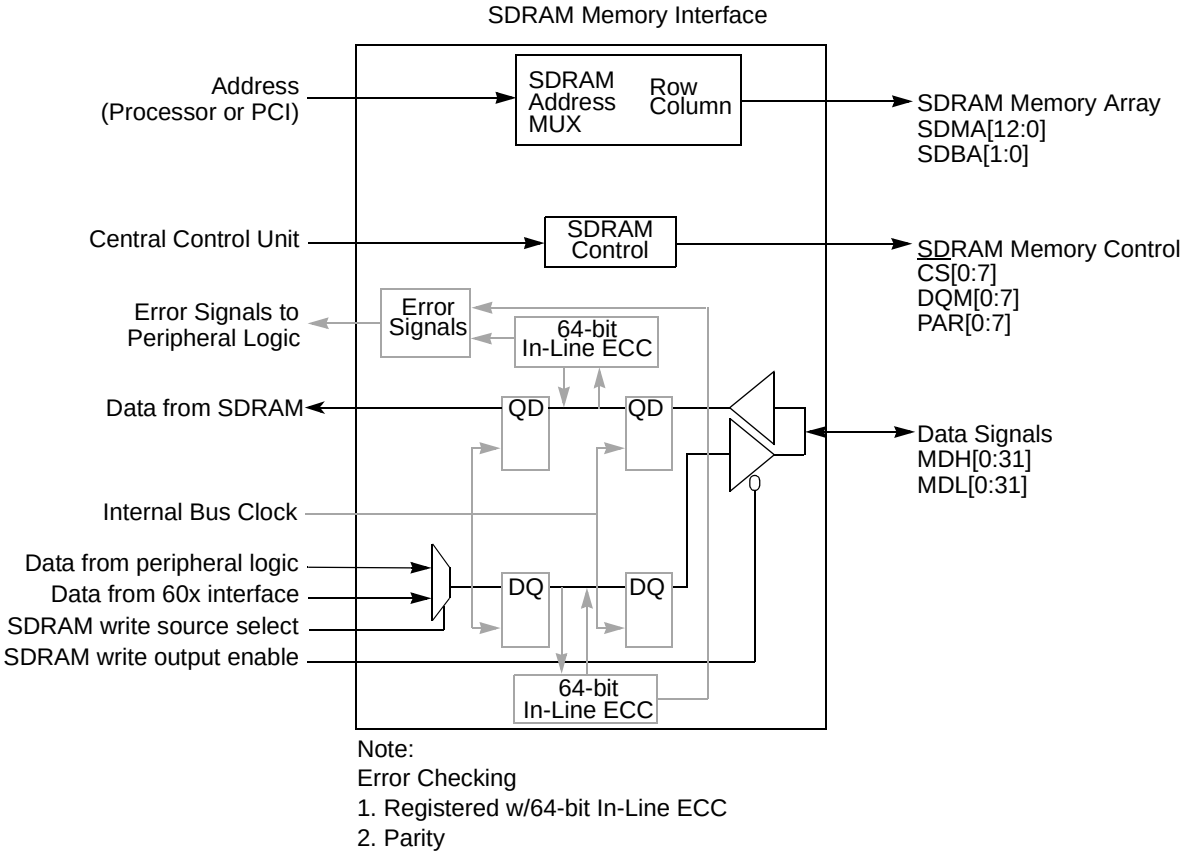


Figure 6-2. SDRAM Memory Interface Block Diagram

The MPC8245 provides control functions and signals for JEDEC-compliant SDRAM. The MPC8245 supplies the SDRAM_CLK[0:3] to be distributed to the SDRAM. These clocks are the same frequency and are in phase with the memory bus clock.

The SDRAM memory bus can be configured to be 64 bits (72 bits with parity), which requires a four-beat SDRAM data burst or configured to be 32 bits (36 bits with parity), which requires an eight-beat SDRAM data burst.

Thirteen row/column multiplexed address signals (SDMA[12:0]) and two bank-select signals (SDBA[1:0]) provide SDRAM addressing for up to 512 Mbytes. The data width of the device determines its density and the physical bank size. Eight chip select signals ($\overline{\text{CS}}$[0:7]) support up to eight banks of memory. Eight SDRAM data in/out mask signals (DQM[0:7]) provide byte selection for 32- and 64-bit accesses. Aan 8-bit SDRAM device has a DQM signal and eight data signals (DQ[0:7]). A 16-bit SDRAM device has two DQM signals associated to specific halves of the sixteen data signals (DQ[0:7] and DQ[8:15]).

Table 6-3 shows relationships between data byte lane 0–7, DQM[0:7], and MDH[0:31] and MDL[0:31] for 32- and 64-bit modes.

Table 6-3. SDRAM Data Bus Lane Assignments

Data Byte Lane	Data In/Out Mask	Data Bus 32-bit Mode	Data Bus 64-bit Mode
$0_{(MSB)}$	DQM[0]	MDH[0:7]	MDH[0:7]
1	DQM[1]	MDH[8:15]	MDH[8:15]
2	DQM[2]	MDH[16:23]	MDH[16:23]
3	DQM[3]	MDH[24:31]	MDH[24:31]
4	DQM[4]	—	MDL[0:7]
5	DQM[5]	—	MDL[8:15]
6	DQM[6]	—	MDL[16:23]
$7_{(LSB)}$	DQM[7]	—	MDL[24:31]

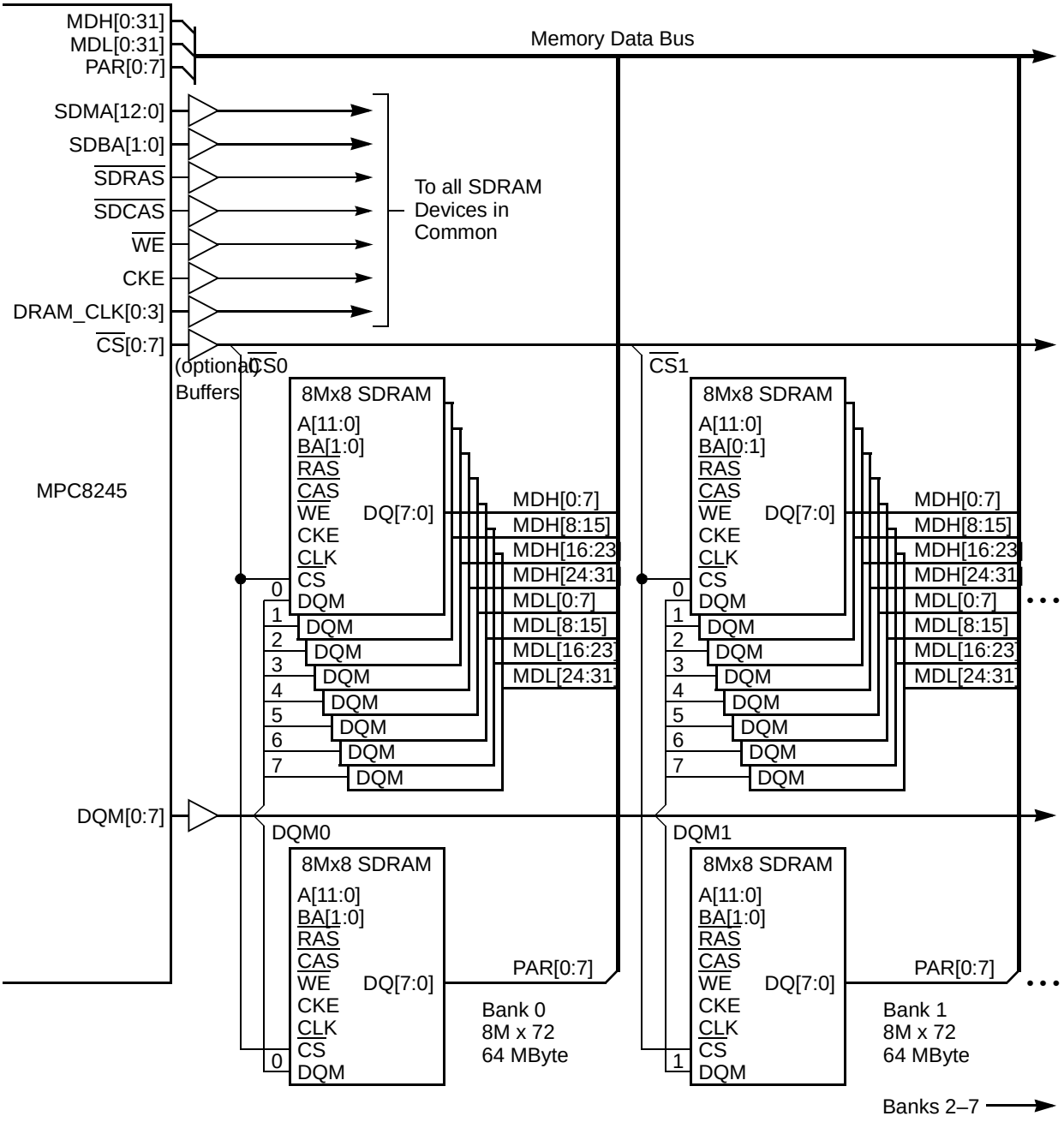
In addition are sixty-four data signals (MDH[0:31] and MDL[0:31]), a write enable signal ($\overline{WE}$), a row address strobe signal ($\overline{SDRAS}$), a column address strobe signal ($\overline{SDCAS}$), a memory clock enable signal (CKE), and eight bidirectional data parity signals (PAR[0:7]). Note that the banks can be built of x1, x4, x8, x16, or x32 SDRAMs as they become available.

Collectively, these interface signals allow a total of 2 Gbyte addressable memory. Programmable $\overline{CAS}$ latency is supported for data read operations. For write operations, the first beat of write data is supplied concurrently with the write command. The memory design must be byte-selectable for writes using MPC8245 DQM outputs.

The MPC8245 allows four simultaneous open pages for page mode; the number of clocks for which the pages are maintained open is programmable by the BSTOPRE and PGMAX parameters. Page register allocation uses a least recently used (LRU) algorithm.

The SDRAM configuration is an eight-bank, 512-Mbyte SDRAM memory array with a 72-bit data bus. Each bank is comprised of nine 8 Mbits x 8 SDRAMs. One of the nine 8 Mbits x 8 SDRAMs is used for the bank's parity checking function. Certain address and control lines may or may not require buffering, depending upon the system design. Analysis of the MPC8245 AC specifications, desired memory operating frequency, capacitive loads, and board routing loads can assist the system designer in deciding whether any signals require buffering. See the *MPC8245 Integrated Processor Hardware Specifications* for more information.

An example SDRAM configuration with 8 banks is shown in Figure 6-3.



NOTES:
1. All signals are connected in common (in parallel) except for CS[0:7], SDRAM_CLK[0:3], the DQM signals used for parity, and the data bus lines.
2. Optional parity memories may use any DQM signal. To minimize loading, a different DQM line is recommended for each bank. For example, DQM0 for Bank 0, DQM1 for Bank 1, etc.
3. Each of the CS[0:7] signals corresponds with a separate physical bank of memory: CS0 for the first bank, etc.
4. Buffering may be needed if large memory arrays are used.
5. SDRAM_CLK[0:3] signals may be apportioned among all memory devices.

Figure 6-3. Example 512-MByte SDRAM Configuration With Parity

6.2.1 Supported SDRAM Organizations

It is not necessary to use identical memory chips in each memory bank because individual memory banks may be different sizes. However, note that the programmable timing parameters are shared among all banks. The MPC8245 multiplexes the row address, column address, and logical bank select bits onto a shared 15-bit memory address bus; individual SDRAM banks may be implemented with memory devices requiring fewer than 28 address bits. The MPC8245 can be configured to provide 13-, 12- or 11-row bits to a particular bank, and 11, 10, 9, 8, or 7 column bits, and 2 or 4 logical banks.

System software must configure the MPC8245 for the correct memory bank sizes. A memory polling algorithm can be used at start-up to determine start and end of memory. Alternately, many DIMMs have an on-board serial-presence-detect (SPD) EEPROM that contains information about the size and timing requirements of the SDRAMs on the DIMM. A software routine can use the I^2C to read the SPD data. Boot firmware can initially set the SDRAM timing parameters with conservative values. Later, when the I^2C routine reads the SPD information from the DIMM, the timing parameters can be adjusted.

The MPC8245 uses its bank map to assert the appropriate $\overline{\text{CS}}$[0:7] signal for memory accesses according to the provided bank depths. System software must also configure the MPC8245 at system start-up to multiplex the row and column address bits appropriately for each bank. Refer to the row-address configuration in MCCR1. Address multiplexing occurs according to these configuration bits.

If a disabled bank has its starting and ending address defined as overlapping an enabled bank's address space, system memory corruption can occur in the overlapping address range. Any unused banks should have their starting and ending addresses programmed out of the range of memory banks in use.

Table 6-4 shows the unsupported multiplexed row and column address bits for 32- and 64-bit modes. Configurations using 7 or 8 column address bits in 32-bit data bus mode and 7 column bits in 64-bit data bus mode are not supported because they would create non-contiguous address spaces.

Table 6-4. Unsupported Multiplexed Row and Column Address Bits

32-bit Data Bus Mode	64-bit Data Bus Mode
13x8	—
12x8	—
11x8	—
12x7	12x7

Table 6-5 summarizes the SDRAM memory configurations supported by the MPC8245. Note that Table 6-5 is not an exhaustive list of all configurations that the MPC8245 can support. The MPC8245 can support any device that can accept the address multiplexing

described in Section 6.2.2, “SDRAM Address Multiplexing,” without exceeding the 2 Gbyte limit on physical memory.

Table 6-5. Supported SDRAM Device Configurations

SDRAM Device Density	Device Organization	Addressing—Row Bits x Column Bits x Logical Banks [1]	MCCR1 [Bank *n* row] setting	Number of Devices in a Physical Bank [2, 3]	Physical Bank Size[2,3] (Mbytes)
16 Mbit (2 banks)	4M x 4 bits	11 x 10 x 2	0b11	16	32
	2M x 8 (or 9) bits	11 x 9 x 2	0b11	8	16
	1M x 16 (or 18) bits	11 x 8 x 2 [4]	0b11	4	8
64 Mbit (4 banks)	16M x 4 bits	13 x 9 x 4	0b10	16	128
		12 x 10 x 4	0b00		
	8M x 8 (or 9) bits	13 x 8 x 4[4]	0b10	8	64
		12 x 9 x 4	0b00		
	4M x 16 (or 18) bits	12 x 8 x 4[4]	0b00	4	32
	2M x 32 (or 36) bits	11 x 8 x 4[4]	0b00	2	16
128 Mbit (4 Banks)	32M x 4 bits	13 x 10 x 4	0b10	16	256
		12 x 11 x 4	0b00		
	16M x 8 (or 9) bits	13 x 9 x 4	0b10	8	128
		12 x 10 x 4	0b00		
	8M x 16 (or 18) bits	13 x 8 x 4[4]	0b10	4	64
		12 x 9 x 4	0b00		
	4M x 32 (or 36) bits	12 x 8 x 4[4]	0b00	2	32
256 Mbit (4 banks)	64M x 4 bits	13 x 11 x 4	0b10	16	512
	32M x 8 (or 9) bits	13 x 10 x 4	0b10	8	256
		12 x 11 x 4	0b00		
	16M x 16 (or 18) bits	13 x 9 x 4	0b10	4	128
		12 x 10 x 4	0b00		
	8M x 32 (or 36) bits	13 x 8 x 4[4]	0b10	2	64
512 Mbit (4 banks)	64M x 8 (or 9) bits	13 x 11 x 4	0b10	8	512
	32M x 16 (or 18) bits	13 x 10 x 4	0b10	4	256
		12 x 11 x 4	0b00		

1 A logical bank is defined for the MPC8245 as a portion of memory addressed by an SDRAM bank select.

2 A physical bank is defined for the MPC8245 as a portion of memory addressed by a single SDRAM chip select. Certain modules of SDRAM may have two physical banks and require two chip selects to be programmed to support a single module.

3 Number of devices and size for physical banks are based on a 64-bit data bus; for a 32-bit data bus, these values would be halved.

4 Not supported by 32-bit data bus.

6.2.2 SDRAM Address Multiplexing

This section describes how the MPC8245 translates processor addresses into SDRAM memory addresses.

The MPC8245 SDRAM memory address signals SDMA[12:0] are labeled with SDMA12 as the most-significant bit (msb) and SDMA0 as the least-significant bit (lsb). Many SDRAM devices are labeled with A0 as the least significant address input. Therefore, the MPC8245 SDMA[12:0] signals should be connected to SDRAM devices according to Table 6-2.

Note that SDMA[14:12] are available only when the MPC8245 is in extended addressing mode, selected by SDMA1 at reset. See Section 2.4, “Configuration Signals Sampled at Reset,” for more information. When using extended addressing mode, the TBEN, $\overline{\text{SRESET}}$, $\overline{\text{CHKSTOP_IN}}$, TRIG_IN, and TRIG_OUT signals are not available. The following pin function changes occur in extended addressing mode:

- TBEN becomes SDMA13
- $\overline{\text{SRESET}}$ becomes SDMA12
- $\overline{\text{CHKSTOP_IN}}$ becomes SDMA14
- TRIG_IN becomes $\overline{\text{RCS2}}$
- TRIG_OUT becomes $\overline{\text{RCS3}}$

Because TBEN is not functional, PICR1[DEC] can be used to enable the processor core’s decrementer.

Table 6-6 shows the multiplexing of the internal physical addresses A[0_{msb}:31_{lsb}] through SDBA[1:0] and SDMA[12:0] during the row and column phases of the 64-bit mode. The shaded cells in Table 6-6 are the unspecified bits.

Table 6-6. SDRAM Address Multiplexing SDBA[1:0] and SDMA[12:0]—64-Bit Mode

Row x Col x Bank		msb Physical Address lsb																																
		0-2			**3**	**4**	**5**	**6**	**7**	**8**	**9**	**10**	**11**	**12**	**13**	**14**	**15**	**16**	**17**	**18**	**19**	**20**	**21**	**22**	**23**	**24**	**25**	**26**	**27**	**28**	**29**	**30**	**31**
11x10x2	SDRAS										BA0	10	9	8	7	6	5	4	3	2	1	0												
	SDCAS								9	8	BA0												7	6	5	4	3	2	1	0			
11x9x2	SDRAS										BA0	10	9	8	7	6	5	4	3	2	1	0												
	SDCAS									8	BA0												7	6	5	4	3	2	1	0			
11x8x2	SDRAS										BA0	10	9	8	7	6	5	4	3	2	1	0												
	SDCAS										BA0												7	6	5	4	3	2	1	0			
12x11x4 [1]	SDRAS								11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0												
	SDCAS					11	9	8		BA1	BA0												7	6	5	4	3	2	1	0			
12x10x4 or 13x9x2	SDRAS								11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0												
	SDCAS						9	8		BA1	BA0												7	6	5	4	3	2	1	0			
12x9x4 or 13x8x2	SDRAS								11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0												
	SDCAS							8		BA1	BA0												7	6	5	4	3	2	1	0			

Table 6-6. SDRAM Address Multiplexing SDBA[1:0] and SDMA[12:0]—64-Bit Mode

Row x Col x Bank		msb Physical Address lsb																															
		0-2			3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
11x8x4, 12x8x4, or 13x8x2	SDRAS								11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS									BA1	BA0												7	6	5	4	3	2	1	0			
13x11x4[1]	SDRAS							12	11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS				11	9	8			BA1	BA0												7	6	5	4	3	2	1	0			
13x10x4	SDRAS							12	11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS					9	8			BA1	BA0												7	6	5	4	3	2	1	0			
13x9x4	SDRAS							12	11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS						8			BA1	BA0												7	6	5	4	3	2	1	0			
13x8x4	SDRAS							12	11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS									BA1	BA0												7	6	5	4	3	2	1	0			

[1] For SDRAMs with 11 column bits, SDMA10 is driven low during the $\overline{\text{SDCAS}}$ phase to indicate a read or write without autoprecharge and SDMA11 is used as the 11th column bit.

Table 6-7 shows the multiplexing of the internal physical addresses A[0_{msb}:31_{lsb}] through SDBA[1:0] and SDMA[12:0] during the row and column phases when operating in 32-bit mode.

Table 6-7. SDRAM Address Multiplexing SDBA[1:0] and SDMA[12:0]—32-Bit Mode

Row x Col x Bank		msb Physical Address lsb																																
		0-4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
11x10x2	SDRAS							BA0	10	9	8	7	6	5	4	3	2	1	0										
	SDCAS					9	BA0												8	7	6	5	4	3	2	1	0		
11x9x2	SDRAS						BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS						BA0												8	7	6	5	4	3	2	1	0		
12x11x4[1]	SDRAS				11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS		11	9		BA1	BA0												8	7	6	5	4	3	2	1	0		
12x10x4 or 13x10x2	SDRAS				11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS			9		BA1	BA0												8	7	6	5	4	3	2	1	0		
12x9x4 or 13x9x2	SDRAS				11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS					BA1	BA0												8	7	6	5	4	3	2	1	0		
13x11x4	SDRAS			12	11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS	11	9			BA1	BA0												8	7	6	5	4	3	2	1	0		

Table 6-7. SDRAM Address Multiplexing SDBA[1:0] and SDMA[12:0]—32-Bit Mode

Row x Col x Bank		msb Physical Address lsb																												
		0-4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
13x10x4	SDRAS			12	11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS		9			BA1	BA0												8	7	6	5	4	3	2	1	0		
13x9x4	SDRAS			12	11	BA1	BA0	10	9	8	7	6	5	4	3	2	1	0											
	SDCAS					BA1	BA0												8	7	6	5	4	3	2	1	0		

[1] For SDRAMs with 11 column bits, SDMA10 is driven low during the $\overline{\text{SDCAS}}$ phase to indicate a read or write without autoprecharge and SDMA11 is used as the 11th column bit.

6.2.3 SDRAM Memory Data Interface

To reduce loading on the data bus, the MPC8245 features on-chip buffers between the internal processor core data bus and the memory data bus. The MPC8245 supports the following types of internal data-path buffering for the SDRAM data interface:

- Registered (default mode for the MPC8245)
- In-line buffer mode

Table 6-8 lists the parameters that determine the data-path buffer mode and control the parity or ECC operation of the MPC8245.

Table 6-8. Memory Data-Path Parameters

Bit Name	Register and Offset	Bit Number in Register
SDRAM_EN	MCCR1 @F0	17
PCKEN	MCCR1 @F0	16
INLINE_WR_EN	MCCR2 @F4	19
INLINE_RD_EN	MCCR2 @F4	18
INLINE_PAR_NOT_ECC	MCCR2 @F4	20
BUF_TYPE[0]	MCCR4 @FC	22
BUF_TYPE[1]	MCCR4 @FC	20
RMW_PAR	MCCR2 @F4	0

Table 6-8. Memory Data-Path Parameters (continued)

Memory parity/ECC enable	ErrEnR1 @C0	2
ECC multi-bit error enable	ErrEnR2 @C4	3

Table 6-9 describes the parameter settings for the available SDRAM data-path buffer options. Note that configuration register bit settings that are not specified in Table 6-9 have undefined behavior.

Table 6-9. SDRAM System Configurations

SDRAM_EN	PCKEN	INLINE_WR_EN	INLINE_RD_EN	INLINE_PAR_NOT_ECC	BUF_TYPE[0]	BUF_TYPE[1]	RMW_PAR	Memory parity/ECC enable	ECC multi-bit error enable	Description
0	0	0	0	0	0	1	0	0	0	Registered, no ECC or parity
0	1	0	0	0	0	1	0	1	0	Registered buffer parity
0	1	0	0	0	0	1	1	1	0	Registered buffer RMW parity
0	0	0	0	0	1	0	0	0	0	In-line, no parity
0	0	1	1	1	1	0	0	1	0	In-line, parity enabled
0	0	1	1	1	1	0	1	1	0	In-line, RMW parity enabled
0	0	0	1	0	1	0	1	1	1	In-line, ECC enabled

The registered buffer mode allows a higher memory interface frequency at the expense of a clock cycle of latency on SDRAM reads. The registered buffer mode interface is shown in Figure 6-4.

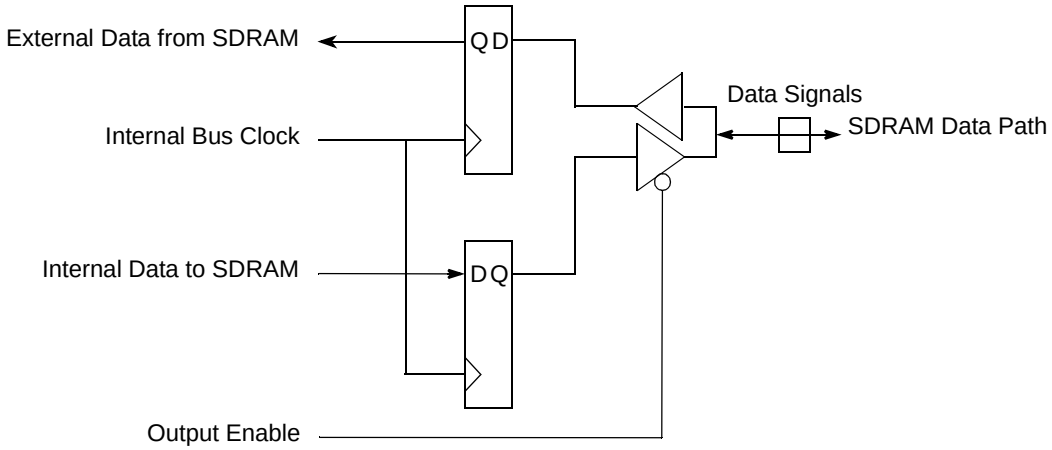


Figure 6-4. SDRAM Registered Memory Interface

In-line buffer mode allows for ECC or parity generation and checking between the internal processor core bus and the external SDRAM data bus. In-line ECC is described in Section 6.2.10, “SDRAM In-Line ECC.” The in-line buffer mode interface is shown in Figure 6-5.

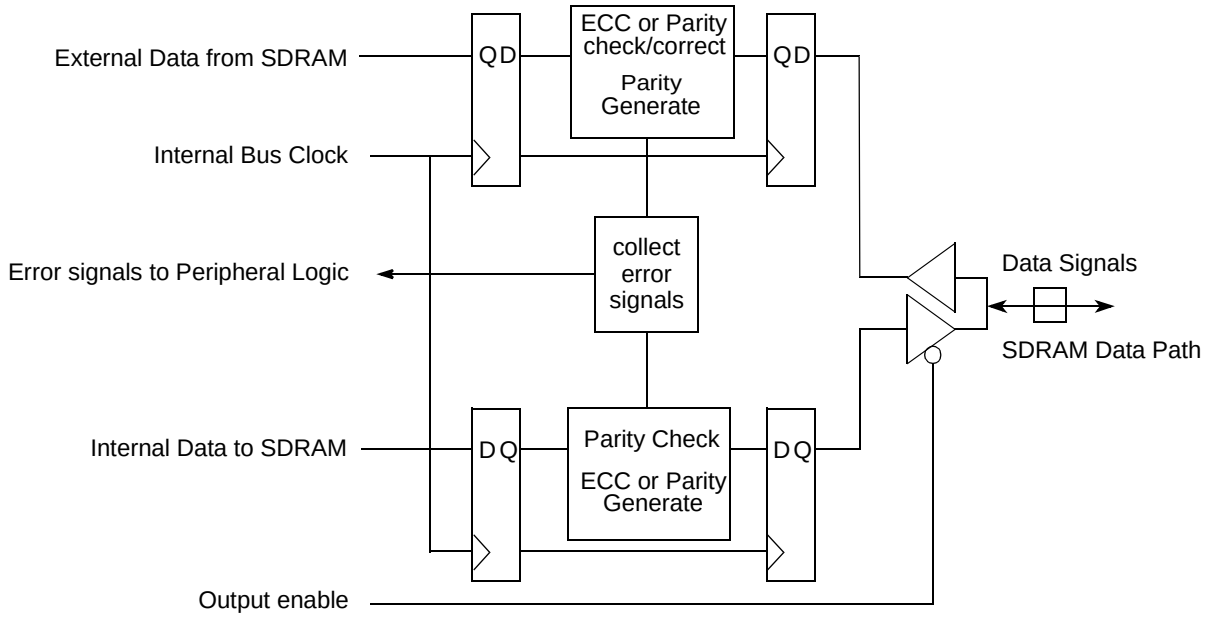


Figure 6-5. SDRAM In-Line ECC/Parity Memory Interface

6.2.4 SDRAM Power-On Initialization

At system reset, initialization software must set up the programmable parameters in the memory interface configuration registers. These include the memory boundary registers, the memory banks enable register, the memory page mode register, and the memory control configuration registers (MCCRs). See Chapter 4, “Configuration Registers,” for more detailed descriptions of the configuration registers.

The following programmable parameters are relevant to the SDRAM interface:

- Memory bank starting and ending addresses (memory boundary registers)
- Memory bank enables
- PGMAX: maximum activate to precharge interval (also called row active time or t_{RAS})
- SREN: self-refresh enable
- SDRAM_EN: SDRAM interface enable
- PCKEN: parity check enable
- Row address configuration for each bank

- INLINE_PAR_NOT_ECC select between ECC or parity on the memory bus for in-line buffer mode only
- INLINE_WR_EN: enable parity error reporting for CPU writes to memory when using in-line buffer mode
- INLRD_PARECC_CHK_EN: enable in-line read path ECC or parity error reporting
- REFINT: interval between refreshes
- RSV_PG: for reserving a page register to allow only three simultaneously open pages
- RMW_PAR: for enabling read-modify-write parity operation
- BSTOPRE: burst to precharge interval (page open interval)
- REFREC: refresh recovery interval from last refresh clock cycle to activate command
- PRETOACT: precharge to activate interval
- ACTOPRE: activate to precharge interval
- BUF_TYPE: for selecting the data-path buffer mode (registered, in-line)
- REGDIMM: for enabling registered DIMM mode
- SDMODE: mode register data to be transferred to SDRAM array by the MPC8245, specifies CAS latency, wrap type, and burst length
- ACTORW: for activating to read or write interval

After configuration of all parameters is complete, system software must set the MCCR1[MEMGO] bit to enable the memory interface. Motorola recommends that software program the MCCRs in-order (that is, MCCR1, MCCR2, MCCR3, MCCR4) without setting MCCR1[MEMGO]. After programming all the MCCRs, software should reprogram MCCR1 with the MEMGO bit set. This sequence is necessary because MCCR1[SDRAM_EN] must be cleared before setting the MCCR4[BUF_TYPE] bits and before the memory interface is enabled with MEMGO.

When the MEMGO bit is set, the MPC8245 performs an initialization sequence to prepare the SDRAM array for accesses. The initialization sequence for JEDEC compliant SDRAM is as follows:

1. Precharge all internal banks of the SDRAM device.
2. Issue 8 refresh commands.
3. Issue mode register set command to initialize the mode register inside the SDRAMs.

When the sequence completes, the SDRAM array is ready for access.

6.2.5 MPC8245 Interface Functionality for JEDEC SDRAMs

All read or write accesses to SDRAM are performed by the MPC8245 using various combinations of the JEDEC standard SDRAM interface commands. The SDRAM interface commands are shown in Table 6-10 as a truth table.

Table 6-10. MPC8245 SDRAM Interface Commands

Command	SDRAS	SDCAS	WE	CS	CKE
Bank activate	0	1	1	0	1
Precharge	0	1	0	0	1
Read [1]	1	0	1	0	1
Write [2]	1	0	0	0	1
CBR refresh	0	0	1	0	1
Mode register set	0	0	0	0	1
Self-refresh	0	0	1	0	0

[1] The MPC8245 does not support the read with autoprecharge command. SDMA10 is driven low during the $\overline{\text{SDCAS}}$ phase. For SDRAMs with 11 column bits SDMA11 is used as the 11th column bit.

[2] The MPC8245 does not support the write with autoprecharge command. For SDRAMs with 11 column bits SDMA11 is used as the 11th column bit.

The SDRAMs sample command and data inputs on rising edges of the memory clock. Additionally, SDRAM output data must be sampled on rising edges of the memory clock. Table 6-10 describes the MPC8245 SDRAM interface command and data inputs.

The MPC8245 provides the following SDRAM interface commands:

- Bank Activate: Latches row address and initiates memory read of that row. Row data is latched in SDRAM sense amplifiers and must be restored by a precharge command before another bank activate is done.
- Precharge: Restores data from the sense amplifiers to the appropriate row. Also initializes the sense amplifiers to prepare for reading another row in the memory array (performing another activate command). Precharge must be performed if the row address changes on next access. The MPC8245 automatically issues a precharge command to the SDRAM when the BSTOPRE or PGMAX intervals have expired, regardless of pending memory transactions from the PCI bus or processor core. See Section 6.2.7, “SDRAM Page Mode,” for more information about the BSTOPRE and PGMAX parameters. The MPC8245 can perform precharge cycles concurrent with snoop broadcasts for PCI transactions.
- Read: Latches column address and transfers data from the selected sense amplifier to the output buffer as determined by the column address. During each succeeding clock, additional data is output without additional read commands. The amount of transferred data is determined by the burst size.

- Write: Latches column address and transfers data from the data signals to the selected sense amplifier as determined by the column address. During each succeeding clock, additional data is transferred to the sense amplifiers from the data signals without additional write commands. The amount of data so transferred is determined by the burst size. Sub-burst write operations are controlled with DQM[0:7].
- Refresh: Similar to CAS before RAS. Causes a row to be read in both memory banks (JEDEC SDRAM) as determined by the refresh row address counter. This refresh row address counter is internal to the SDRAM. After being read, the row is automatically rewritten in the memory array. Before execution of refresh, all memory banks must be in a precharged state.
- Mode register set: Allows setting of SDRAM options for configuration. This command is performed by the MPC8245 during system initialization. The mode register data (CAS latency, burst length, and burst type) is provided by MCCR4[SDMODE] and subsequently transferred to the SDRAM array by the MPC8245 after MEMGO is enabled.
  - CAS latency may be chosen as provided by the preferred SDRAM. (Some SDRAMs provide CAS latency 1, 2, 3; some provide CAS latency 1, 2, 3, 4).
  - Burst type must be set to sequential.
  - Although some SDRAMs provide variable burst lengths of 1, 2, 4, 8 page size, the MPC8245 supports only a burst length of 4 or 8. Burst length 4 must be selected for operation with a 64-bit memory interface; burst length 8 must be selected for operation with a 32-bit memory interface. Burst lengths of 1 and 2 page size are not supported by the MPC8245.
- Self-refresh: Used when the device is in standby for long periods of time. Automatically generates internal refresh cycles to keep the data in both memory banks refreshed. Before execution of this command, all memory banks must be in a precharged state.

6.2.6 SDRAM Burst and Single-Beat Transactions

In 64-bit data bus mode, the MPC8245 performs a four-beat burst for every transaction (burst and single-beat); in 32-bit data bus mode, the MPC8245 performs an eight-beat burst for every transaction (burst and single-beat). The burst is always sequential, and the critical double word is always supplied first. For example, in 64-bit data bus mode, if the processor core requests the third double word of a cache block, the MPC8245 reads double words from memory in the order 2-3-0-1. In 32-bit data bus mode, if the processor core requests the third double word of a cache block, the MPC8245 reads words from memory in the order 4-5-6-7-0-1-2-3.

For single-beat read transactions, the MPC8245 masks the extraneous data in the burst by driving the DQM[0:7] signals high on the irrelevant cycles. For single-beat write

transactions, the MPC8245 protects non-targeted addresses by driving the DQM[0:7] signals high on the irrelevant cycles. For single-beat transactions, the bursts cannot be terminated early. That is, if the relevant data is in the first data phase, the subsequent data phases of the burst must run to completion even though the data is irrelevant.

6.2.7 SDRAM Page Mode

Under the following conditions, the MPC8245 retains four active SDRAM pages for burst or single-beat accesses:

- A pending transaction (read or write) hits one of the currently active internal pages.
- No pending refreshes exist.
- The burst-to-precharge interval (controlled by BSTOPRE[0:9]) has not been exceeded.
- The maximum activate-to-precharge interval (controlled by PGMAX) has not been exceeded.
- MCCR2[RSV_PG] = 0b0. In this case, only three active pages are allowed.

Page mode can dramatically reduce access latencies for page hits. Depending on the memory system design and timing parameters, using page mode can save clock cycles from subsequent burst accesses that hit in an active page. SDRAM page mode is controlled by the BSTOPRE[0:9] and PGMAX parameters. Page mode is disabled by clearing either the PGMAX or BSTOPRE[0:9] parameters.

BSTOPRE[0:9] controls the burst-to-precharge interval. Note that the BSTOPRE[0:9] parameter is composed of BSTOPRE[0:1] (bits 19–18 of MCCR4), BSTOPRE[2:5] (bits 31–28 of MCCR3), and BSTOPRE[6:9] (bits 3–0 of MCCR4). The page open duration counter is loaded with BSTOPRE[0:9] every time the page is accessed (including page hits). When the counter expires (or when PGMAX expires) the open page is closed with a precharge bank command. Page hits can occur at any time in the interval specified by BSTOPRE[0:9].

The BSTOPRE interval can be optimized for the particular system implementation. If memory accesses are typically to the same rows within an active page, a longer BSTOPRE interval would improve performance. Alternately, if memory accesses are typically to several locations spanning multiple pages, a shorter duration for BSTOPRE[0:9] is in order. to allow for a precharge to close the active page before a subsequent access activates another page. Note that when BSTOPRE[0:9] is programmed to 0x000, page mode is disabled.

The 1-byte memory page mode register (MPMR) contains the PGMAX parameter that controls how long the MPC8245 retains the currently accessed page (row) in memory. The PGMAX parameter specifies the activate-to-precharge interval (t_{RAS}). The PGMAX value

is multiplied by 64 to generate the actual number of clock cycles for the interval. When PGMAX is programmed to 0x00, page mode is disabled.

The value for PGMAX depends on the specific SDRAM devices used, the ROM system, and the operating frequency of the MPC8245. When the interval specified by PGMAX expires, the MPC8245 must close the active page by issuing a precharge bank command. PGMAX must be sufficiently less than the maximum row active time for the SDRAM device to ensure that the issuing of a precharge command is not stalled by a memory access. When PGMAX expires during a memory access, the MPC8245 must wait for the access to complete before issuing the precharge command to the SDRAM. In the worst case, the MPC8245 initiates a memory access one clock cycle before PGMAX expires. If ROM is located on the memory bus, the longest access that could potentially stall a precharge is a burst read from ROM. If ROM is located on the PCI bus, the longest memory access is a burst read from the SDRAM.

The MPC8245 also requires two clock cycles to issue a precharge bank command to the SDRAM device so the PGMAX interval must be further reduced by two clock cycles. Therefore, PGMAX should be programmed according to the following equation:

$$PGMAX < [t_{RAS(MAX)} - (\text{worst-case memory access}) - 2] / 64$$

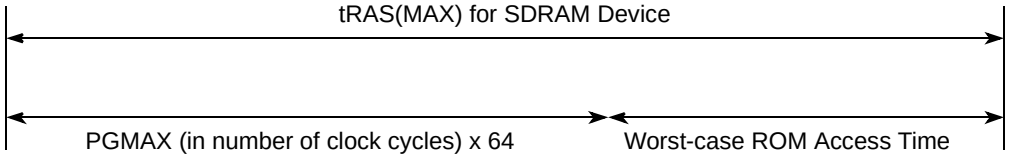


Figure 6-6. PGMAX Parameter Setting for SDRAM Interface

For example, consider a system with a memory bus clock frequency of 66 MHz using SDRAMs with a maximum row active time ($t_{RAS(MAX)}$) of 100 µs. The maximum number of clock cycles between activate bank and precharge bank commands is 66 MHz x 100 µs = 6600 clock cycles.

If the system uses 8-bit ROMs on the memory bus, a processor burst read (a 32-byte cache line read) from ROM (a non-bursting ROM device) follows the timing shown in Figure 6-43. MCCR2[TS_WAIT_TIMER] also affects the ROM access time. The minimum time allowed for ROM devices to enter high impedance is two clock cycles. TS_WAIT_TIMER adds clocks (*n*–1) to the minimum disable time. This delay is enforced after all ROM accesses preventing any other memory access from starting. Therefore a burst read from an 8-bit ROM (worst-case access time (wcat)) takes:

{[(ROMFAL + 2) x 8 + 3] x 4} + [2 + (TS_WAIT_TIMER – 1)] clock cycles

So, if MCCR1[ROMFAL] = 4 and MCCR2[TS_WAIT_TIMER] = 3, the interval for a local processor burst read from an 8-bit ROM takes

{[(4 + 2) x 8 + 3] x 4} + [2 + (3 – 1)] = 204 + 4 = 208 clock cycles.

Plugging the values into the PGMAX equation above,

PGMAX < (6600 – 213 – 2) ÷ 64 = 99.8 clock cycles.

The value stored in PGMAX would be 0b0110_0011 (99 clock cycles).

6.2.7.1 SDRAM Paging in Sleep Mode

Systems that attempt to go to sleep with enabled SDRAM paging must ensure that the following sequence of events occurs in software before the processor core enters sleep mode:

1. Disable page mode by writing 0x00 to MPMR[PGMAX].
2. Wait for any open pages to close by allowing a SDRAM refresh interval to elapse; MCCR[REFINT], bits (15:2).
3. Processor core enters sleep mode.

On waking from sleep, software must perform the following sequence to re-enable paging, if so desired.

1. Awake from sleep.
2. Enable page mode by writing the appropriate maximum page open interval based upon the system design to MPMR[PGMAX] (optional).

6.2.8 SDRAM Interface Timing

To accommodate available memory technology across a wide spectrum of operating frequencies, the MPC8245 allows the following SDRAM interface timing intervals to be programmable with granularity of 1 memory clock cycle:

- REFREC—Refresh command to activate command interval
- ACTORW—Activate command to read or write command interval
- ACTOPRE—Activate command to precharge command interval
- PRETOACT—Precharge command to activate command interval
- BSTOPRE—Burst to precharge command interval (page open interval)

The SDRAM interface timing intervals are defined in Table 6-11.

Table 6-11. SDRAM Interface Timing Intervals

Timing Intervals	Definition
REFREC	The number of clock cycles from the refresh command until an activate command is allowed. This can be calculated by referring to the AC specification of the SDRAM device. The AC specification indicates a minimum refresh to activate interval in nanoseconds.
ACTORW	The number of clock cycles from an activate command until a read or write command is allowed. This interval (nS) will be listed in the AC specifications of the user's SDRAM.

Table 6-11. SDRAM Interface Timing Intervals (continued)

Timing Intervals	Definition
ACTOPRE	The number of clock cycles from an activate command until a precharge command is allowed. This interval (nS) will be listed in the AC specifications of the user's SDRAM.
PRETOACT	The number of clock cycles from a precharge command until an activate command is allowed. This interval (nS) will be listed in the AC specifications of the user's SDRAM.
BSTOPRE	The number of clock cycles to maintain a page open after an access. A subsequent access can generate a page hit during this interval. A page hit reloads the BSTOPRE counter. When the interval expires, a precharge is issued to the page.

The value of the above five parameters (in whole clock cycles) must be set by boot code at system start-up and kept in the MPC8245 configuration register space.

The following figures show SDRAM timing for various types of accesses. Figure 6-7 shows a single-beat read operation.

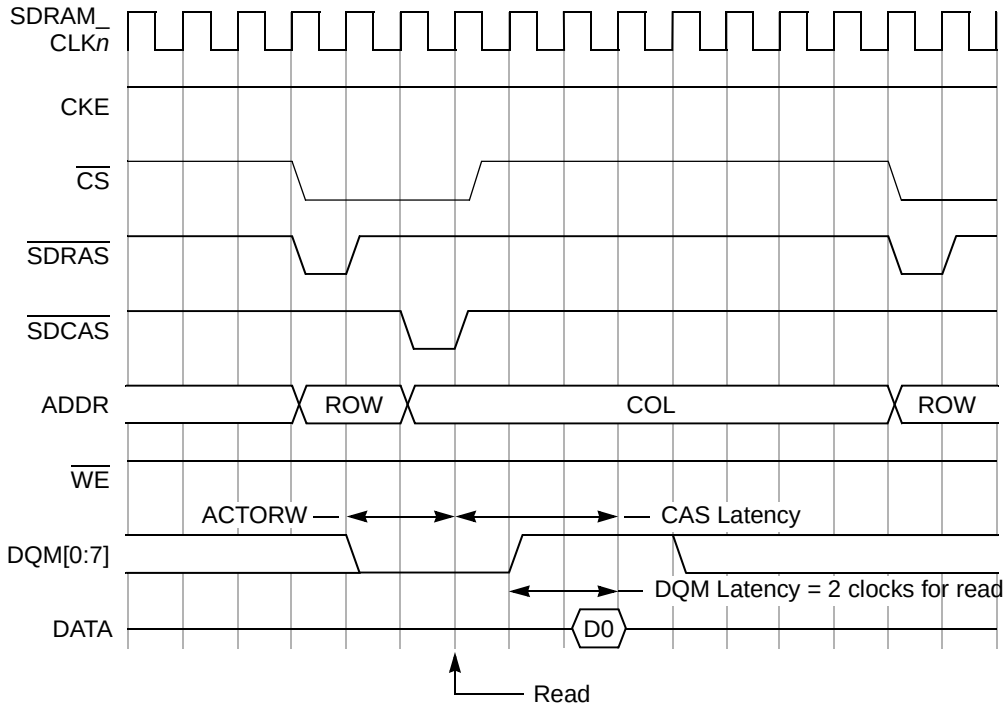


Figure 6-7. SDRAM Single-Beat Read Timing (SDRAM Burst Length = 4)

Figure 6-8 shows a four-beat burst read operation.

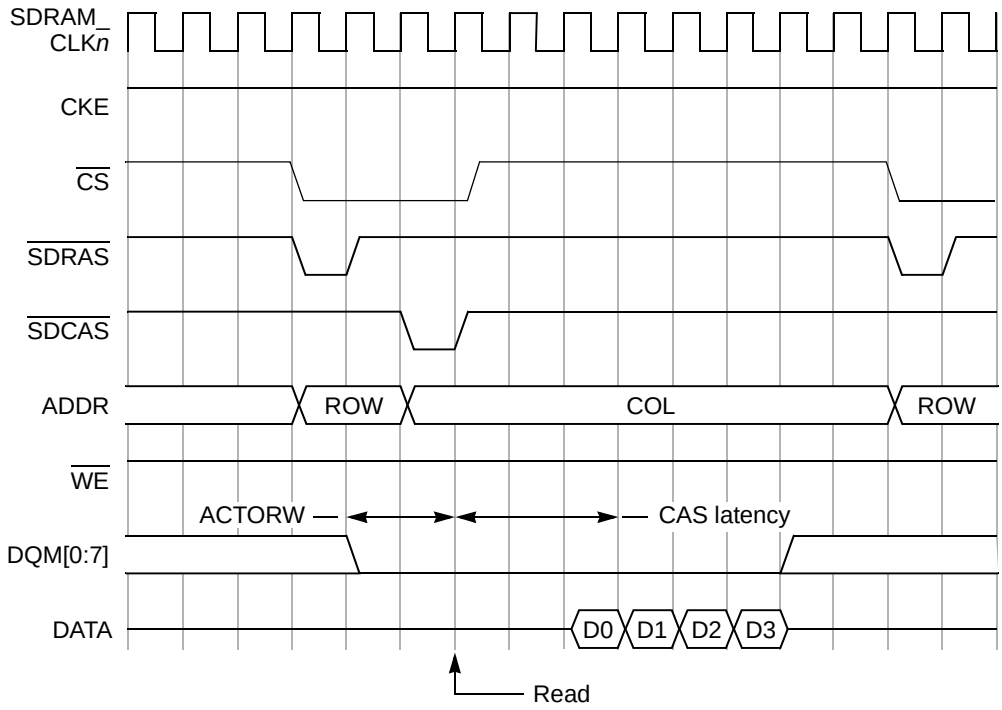


Figure 6-8. SDRAM Four-Beat Burst Read Timing Configuration—64-Bit Mode

Figure 6-9 shows an eight-beat burst read operation.

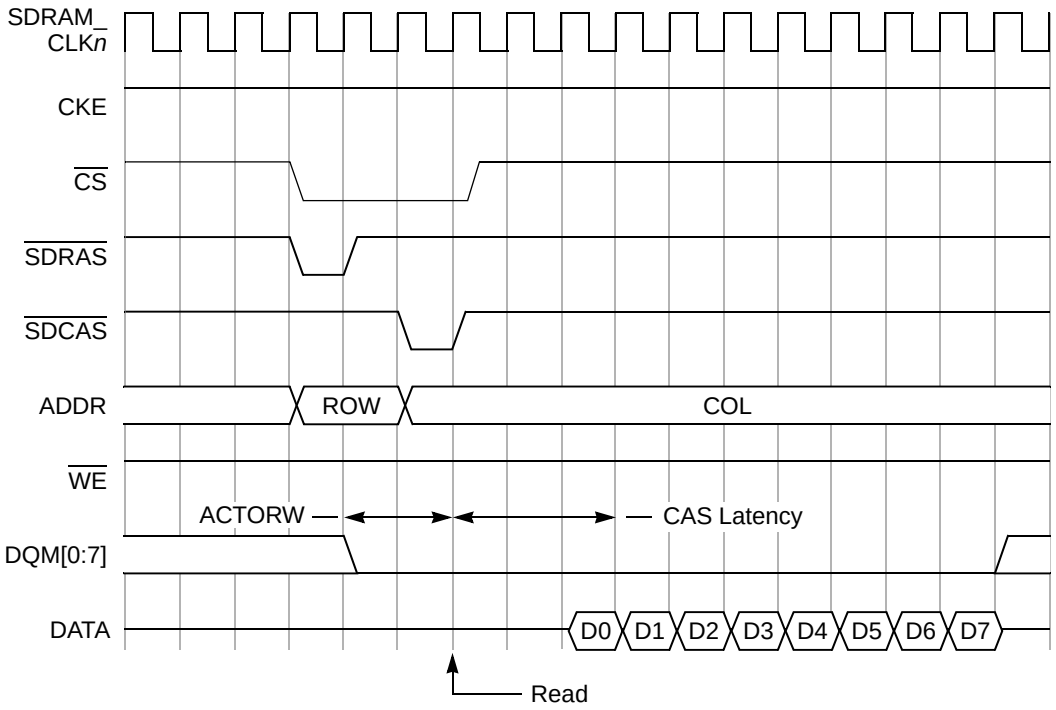


Figure 6-9. SDRAM Eight-Beat Burst Read Timing Configuration—32-Bit Mode

Figure 6-10 shows a single-beat write operation.

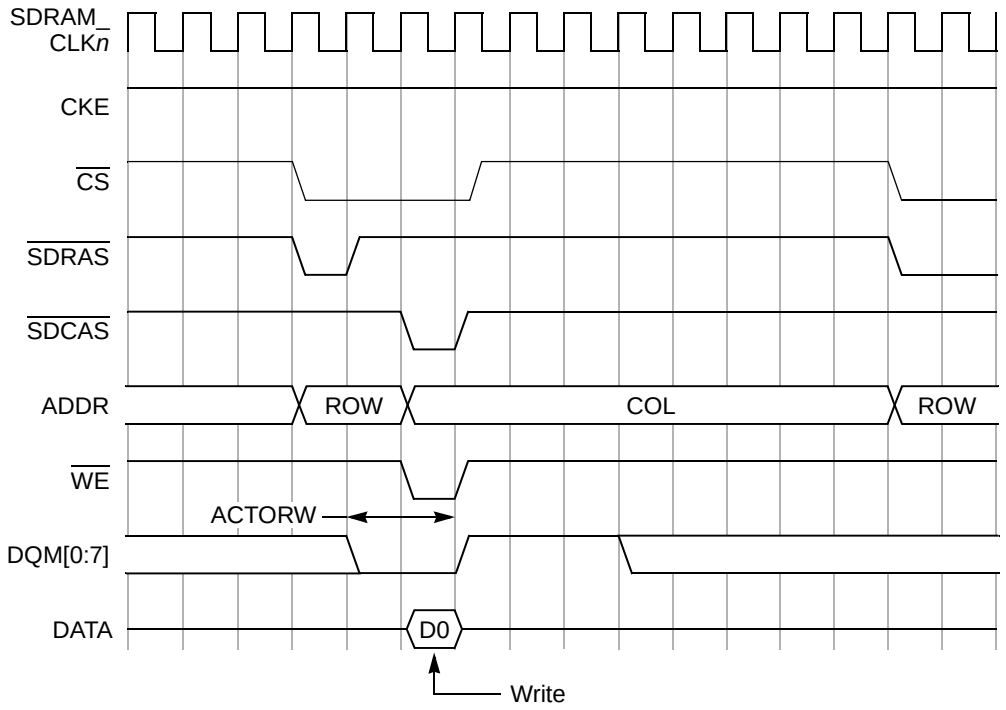


Figure 6-10. SDRAM Single-Beat Write Timing (SDRAM Burst Length = 4)

Figure 6-11 shows a 4-beat burst-write operation.

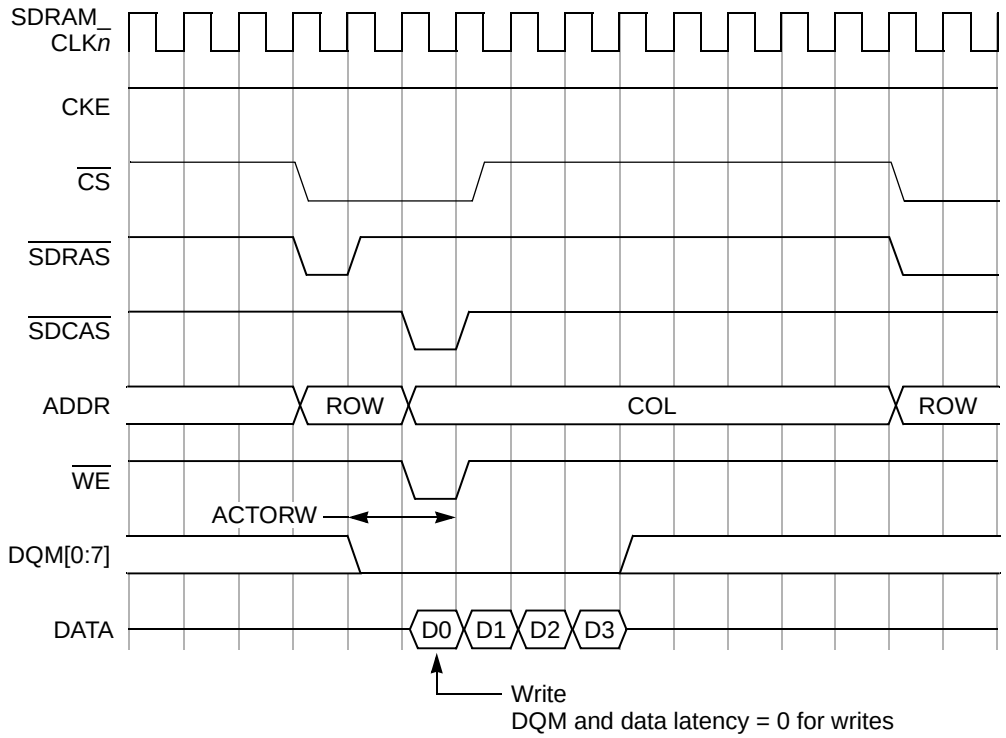


Figure 6-11. SDRAM Four-Beat Burst Write Timing—64-Bit Mode

Figure 6-12 shows an 8-beat burst-write operation.

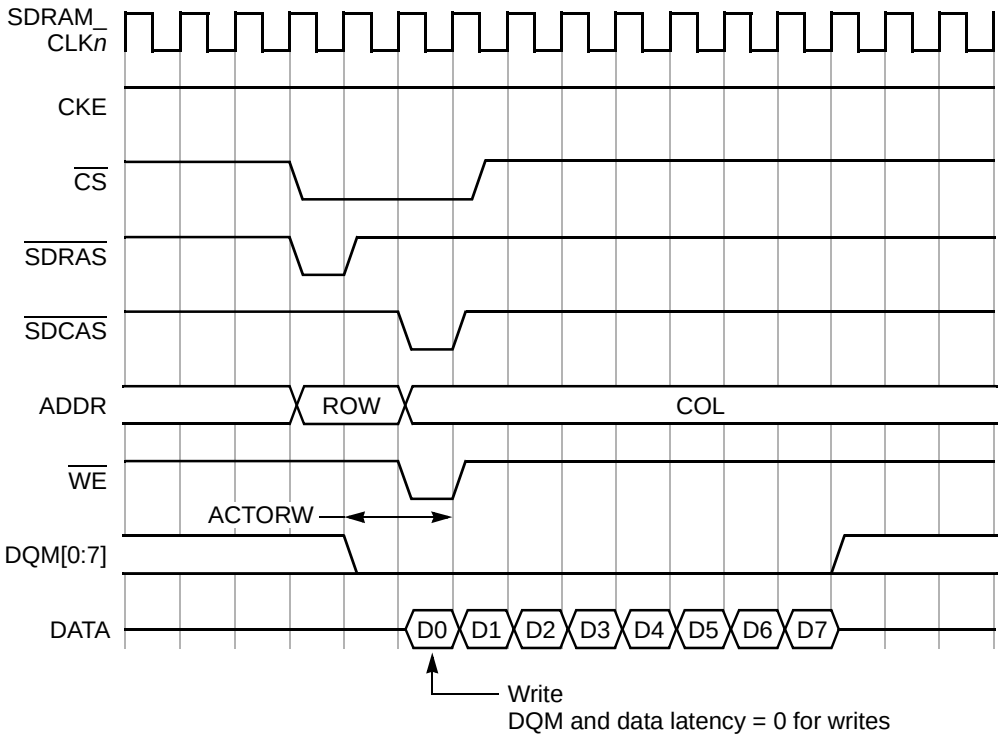


Figure 6-12. SDRAM Eight-Beat Burst Write Timing—32-Bit Mode

6.2.8.1 SDRAM Mode-Set Command Timing

The MPC8245 transfers the mode register data, (CAS latency, burst length, and burst type) stored in MCCR4[SDMODE] to the SDRAM array by issuing the mode-set command when MCCR1[MEMGO] is set. The timing of the mode-set command is shown in Figure 6-13.

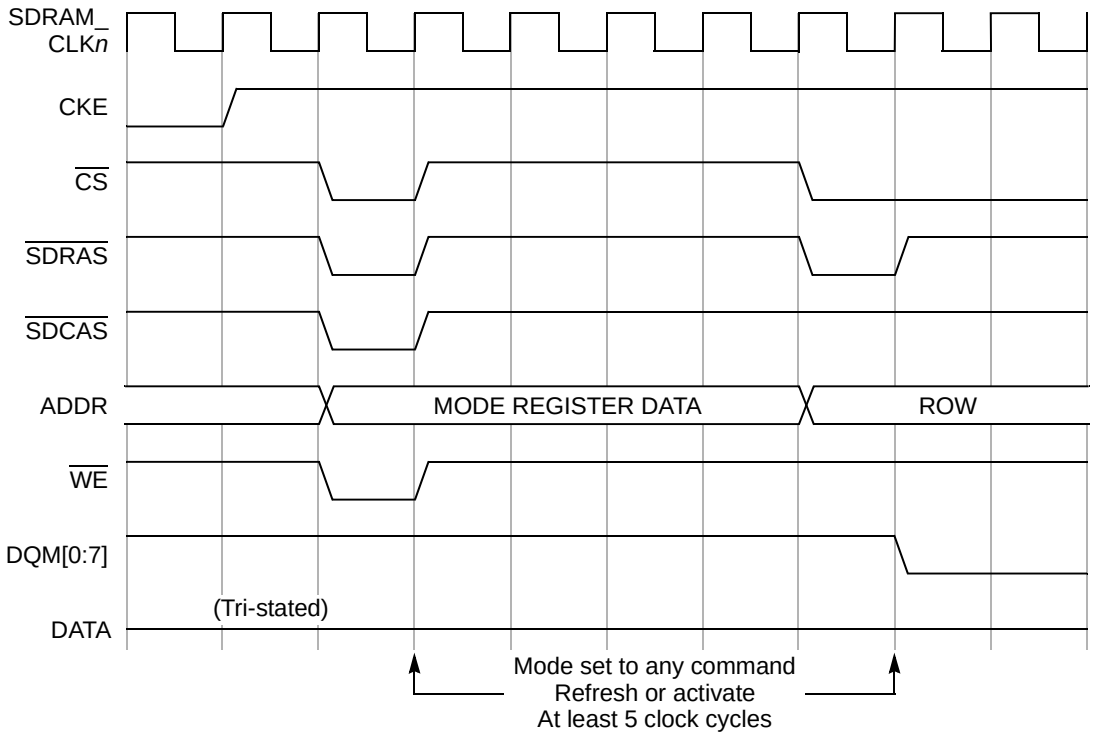


Figure 6-13. SDRAM Mode Register Set Timing

6.2.9 SDRAM Parity and RMW Parity

When configured for SDRAM, the MPC8245 supports two forms of parity checking and generation, normal parity and read-modify-write (RMW) parity. Normal parity assumes that each of the eight parity bits is controlled by a separate DQM signal. Thus, for a single-beat write to system memory, the MPC8245 generates a parity bit for each byte written to memory.

Because RMW parity assumes that all eight parity bits are controlled by a single DQM signal, all parity bits must be written as a single 8-bit quantity (byte). For any system memory write operations smaller than a double word, the MPC8245 must latch the write data, read a double word (64 bits), check the parity of that double word, merge it with the write data, regenerate parity for the new double word, and finally write the new double word back to memory.

The MPC8245 checks parity on all memory reads, provided parity checking is enabled (PCKEN = 1). The MPC8245 generates parity for the following operations:

- PCI to memory write operations
- Processor core single-beat write operations with RMW parity enabled (RMW_PAR = 1)

The processor core is expected to generate parity for all other memory write operations.

Note that the MPC8245 does not support RMW parity mode when in 32-bit data path mode (RMW_PAR = 0).

6.2.9.1 RMW Parity Latency Considerations

When RMW parity is enabled, the time required to read, modify, and write increases latency for both processor single-beat writes and PCI writes to system memory. All other transactions are unaffected and operate as in normal parity mode.

For processor core single-beat writes to system memory, the MPC8245 latches the data, reads a double word from system memory (checking parity), and merges that double word with the write data from the processor. The MPC8245 then generates new parity bits for the merged double word and writes the data and parity to memory. The RMW process adds six clock cycles to a single-beat write operation. If page mode retention is enabled (BSTOPRE > 0 and PGMAX > 0), the MPC8245 keeps the memory in page mode for the RMW sequence. Because the processor drives all eight parity bits during burst writes to system memory, these transactions go directly to the SDRAMs with no performance penalty.

For PCI writes to system memory with RMW parity enabled, the MPC8245 latches the data in the internal PCI-to-system-memory-write buffer (PCMWB). If the PCI master writes complete double words to system memory, the MPC8245 generates the parity bits when the PCMWB is flushed to memory. However, if the PCI master writes 32-, 16-, or 8-bit data that cannot be gathered into a complete double word in the PCMWB, a RMW operation is required. The MPC8245 performs a double-word read from system memory (checking parity), and then merges the write data from the PCI master with the data read from memory. The MPC8245 then generates new parity for the merged double word and writes the data and parity to memory. If page mode retention is enabled (BSTOPRE > 0 and PGMAX > 0), the MPC8245 keeps the memory in page mode for the RMW sequence.

6.2.10 SDRAM In-Line ECC

As an alternative to simple parity, the MPC8245 supports ECC for the data path between the MPC8245 and system memory. ECC not only allows the MPC8245 to detect errors in the memory data path but also to correct single-bit errors in the 64-bit data path. Note that ECC is not supported for systems using a 32-bit data bus. ECC requires a read-modify-write to perform sub-double-word write operations.

The in-line ECC and parity data-path option allows the MPC8245 to detect and automatically correct single bit ECC errors; detect multiple bit ECC errors or parity errors

with only one clock cycle penalty on CPU and PCI memory read operations; and generate parity for the internal processor data bus. For CPU and PCI memory write operations, parity can be checked automatically on the internal processor data bus and either ECC or parity generated for the memory bus. Table 6-8 and Table 6-9 describe the configuration requirements for this mode.

The in-line ECC logic in the MPC8245 detects and corrects all single-bit errors and detects all double-bit errors and all errors within a nibble. Other errors are not guaranteed to be detected or corrected. Multiple-bit errors are always reported if detected. However, when a single-bit error occurs, the value in the ECC single bit error counter register is compared to the ECC single bit error trigger register. If the values are not equal, no error is reported; if the values are equal, then an error is reported. Thus, the single-bit error registers may be programmed so that minor faults with memory are corrected and ignored, but a catastrophic memory failure generates an interrupt. See Section 4.8.1, “ECC Single-Bit Error Registers,” for more information on these registers.

MPC8245 supports concurrent ECC for the memory data path and parity for the local processor data path. ECC and parity may be independently enabled or disabled. The eight signals used for ECC (PAR[0:7]) are also used for processor core parity. MPC8245 checks ECC on 64-bit memory reads.

The syndrome equations for the ECC codes are shown in Table 6-12 and Table 6-13.

Table 6-12. MPC8245 SDRAM ECC Syndrome Encoding (Data Bits 0-31)

Syndrome Bit	Data Bit																															
	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
0	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x				x				x				x				x
1	x				x				x				x				x	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x
2		x				x				x				x			x				x				x				x			
3			x				x				x				x			x				x				x				x		
4				x				x				x				x			x	x			x	x			x	x			x	x
5					x	x	x	x					x	x	x	x					x	x	x	x					x	x	x	x
6									x	x	x	x	x	x	x	x									x	x	x	x	x	x	x	x
7	x	x	x	x									x	x	x	x	x	x	x					x				x	x	x	x	

Table 6-13. The MPC8245 SDRAM ECC Syndrome Encoding (Data Bits 32-63)

Syndrome Bit	Data Bit																															
	32	33	34	35	36	37	38	39	40	41	42	43	44	45	46	47	48	49	50	51	52	53	54	55	56	57	58	59	60	61	62	63
0			x				x				x				x					x				x				x		x		
1				x				x				x				x	x				x				x						x	
2	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x		x				x				x						x
3	x				x				x				x						x				x				x		x	x	x	x
4		x	x	x		x	x	x		x	x	x		x	x	x													x	x	x	x
5					x	x	x	x					x	x	x	x	x	x	x	x	x	x	x	x								
6									x	x	x	x	x	x	x	x	x	x	x	x					x	x	x	x	x	x	x	x
7	x	x					x	x			x	x	x	x							x	x	x	x	x	x	x	x		x	x	x

Note that software must initialize the values of the ECC bits to accurate values. The following procedure may be used to initialize the ECC bits:

1. Clear MCCR1[MEMGO] and configure the memory size and timing parameters.
2. Turn on in-line ECC generation by setting the configuration parameters as described in Table 6-9.
3. Turn off ECC checking/error reporting by clearing the following:

ECC single-bit trigger register (all bits of the register at 0xB9)

- ErrEnR1[memory parity/ECC enable] (bit 2 of the register at 0xC0)
- ErrEnR2[ECC multi-bit error enable] (bit 3 of the register at 0xC4)
- MCCR2[INLINE_RD_EN] (bit 18 of the register at 0xF4)

4. Turn on the memory controller by setting MEMGO.
5. Perform a sequence of writes to all memory, causing the ECC generation logic to initialize all ECC bits.
6. Turn on ECC error checking/error reporting by setting the bits that were cleared in step 3 above.

6.2.11 SDRAM Registered DIMM Mode

The MPC8245 can be configured to support registered SDRAM DIMMs. To reduce loading, registered DIMMs latch the SDRAM control signals internally before using them to access the array. Enabling the MPC8245's registered DIMM mode (MCCR4 bit 15, REGDIMM = 1) compensates for this delay on the DIMMs control bus by delaying the MPC8245's data and parity buses for SDRAM writes by one additional clock cycle.

Enabling registered DIMM mode has no affect on the bus timing for SDRAM reads or ROM/Flash transfers. However, the internal read latency time for SDRAM reads is increased by one clock to compensate for the latch delay on the control signals of the registered DIMM. Figure 6-14 shows the registered SDRAM DIMM single-beat write timing.

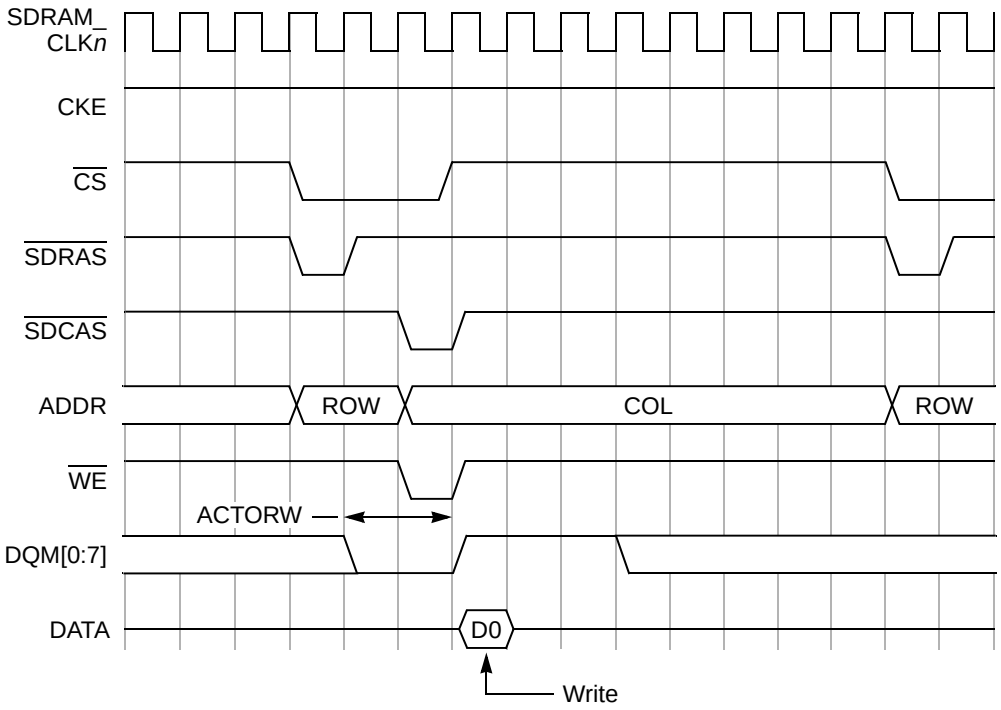


Figure 6-14. Registered SDRAM DIMM Single-Beat Write Timing

Figure 6-15 shows the registered SDRAM DIMM burst-write timing.

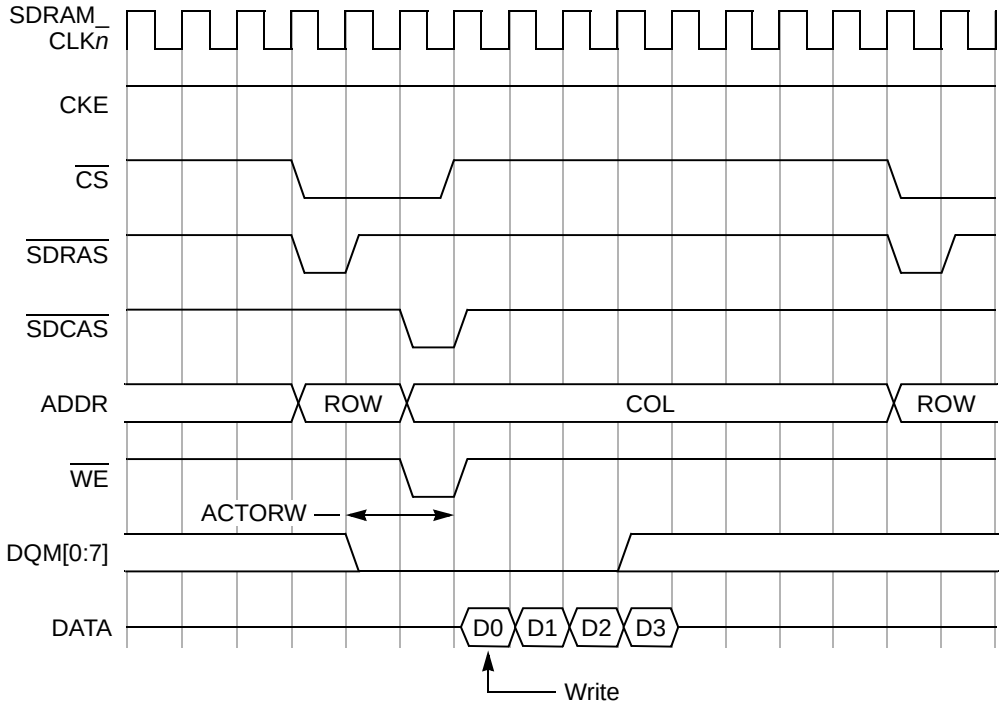


Figure 6-15. Registered SDRAM DIMM Burst-Write Timing

6.2.12 SDRAM Refresh

The memory interface supplies CBR refreshes to SDRAM according to the interval specified in MCCR2[REFINT]. REFINT is the refresh interval. When REFINT expires and the memory bus is idle, the MPC8245 issues a precharge and then a refresh command to the SDRAM devices. However, if the memory bus is busy with a transaction, the refresh request is not performed and an internal, 4-bit, missed-refresh counter is incremented. The refresh interval timer is reset to the value in REFINT and the process begins again. When the bus is idle, the MPC8245 performs all missed refreshes back to back and the missed counter is cleared. If the number of missed refreshes exceeds 16, the counter overflows and causes a refresh overflow error. See Section 14.3.2.4, “Memory Refresh Overflow Error,” for more information about the reporting of these errors. In the worst case, the MPC8245 misses 16 refreshes and must perform all 16 refreshes. Figure 6-16 shows this worst-case situation repeated over the device’s refresh period.

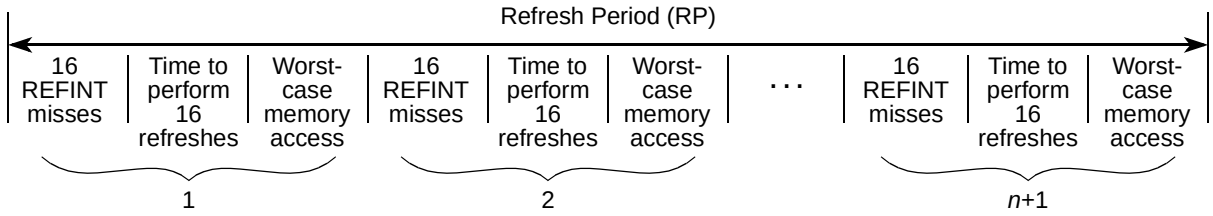


Figure 6-16. SDRAM Refresh Period

The value stored in REFINT must permit the MPC8245 to supply refreshes within the refresh period specified by the SDRAM device. Another factor in calculating the value for REFINT is the overhead for the MPC8245 to issue a refresh command to the SDRAM device. The MPC8245 has to precharge any open banks before it can issue the refresh command. The MPC8245 requires two clock cycles to issue a precharge to an internal bank; with the possibility of four banks open simultaneously, this equates to eight clock cycles. The MPC8245 must also wait for the PRETOACT interval to pass before issuing the refresh command. The refresh command itself takes four clock cycles (see Figure 6-17) with a dead cycle needed between subsequent refresh commands.

REFINT must also allow for a potential collision between memory accesses and refresh cycles. In the worst case, the refresh may have to wait the number of clock cycles required by the longest access. For example, if a local ROM access is in progress at the time a refresh operation needs to be performed, the refresh must wait until the ROM access has completed. If ROM is local, the longest access that could potentially stall a refresh is a burst read from ROM. If ROM is located on the PCI bus, the longest memory access is a burst read from the SDRAM.

Therefore, REFINT should be programmed according to the following equation:

$$\text{REFINT} < \frac{\text{RP}}{(n+1)16} - \frac{16(\text{ROH})}{16} - \frac{\text{TWACC}}{16}$$

Where:

RP is the refresh period of the device = refresh period per bank x the number of banks x memory frequency

n = (the number of rows per bank x the number of banks per device) ÷ 16

ROH is the refresh overhead imposed by the MPC8245 and is composed of the precharge, the PRETOACT interval, the 4 clock cycles to issue the refresh command, and one dead cycle between refreshes.

TWACC is the worst-case access time for the slowest device on the memory bus.

Consider a typical SDRAM device having two internal banks, 2K rows in each bank (4K rows total) with a refresh period of 32 ms for 2K rows. This means that the MPC8245 must refresh each internal bank (2K rows) every 32 ms. In this example there are two banks, so to refresh the whole SDRAM, it takes 64 ms. If the memory bus operates at 66 MHz, RP = 64 ms x 66 MHz = 4,224,000 clock cycles to refresh all 4K rows. In this example *n* = 2048 x 2 ÷ 16 = 256. So, the value of the first term in the REFINT equation above is 4,224,000 ÷ [(256 + 1) x 16] = 1,027.237

For this example, suppose PRETOACT is set to 2 clock cycles. In this case,
ROH = (2 x 2) + 2 + 4 + 1 = 11

If the system uses 8-bit ROMs on the local memory bus, a burst read from ROM will follow the timing shown in Figure 6-43. In addition, the minimum time allowed for ROM devices

to enter high impedance is two clock cycles. This delay is enforced after all ROM accesses preventing any other memory access from starting. Therefore a burst read from an 8-bit ROM will take:

{[(ROMFAL + 2) x 8 + 3] x 4 + 5} + 2 clock cycles

So, if MCCR1[ROMFAL] = 4, the interval for a processor burst read from an 8-bit ROM will take:

{[(4 + 2) x 8 + 3] x 4 + 5} + 2 = 211 clock cycles

Plugging the values into the REFINT equation above:

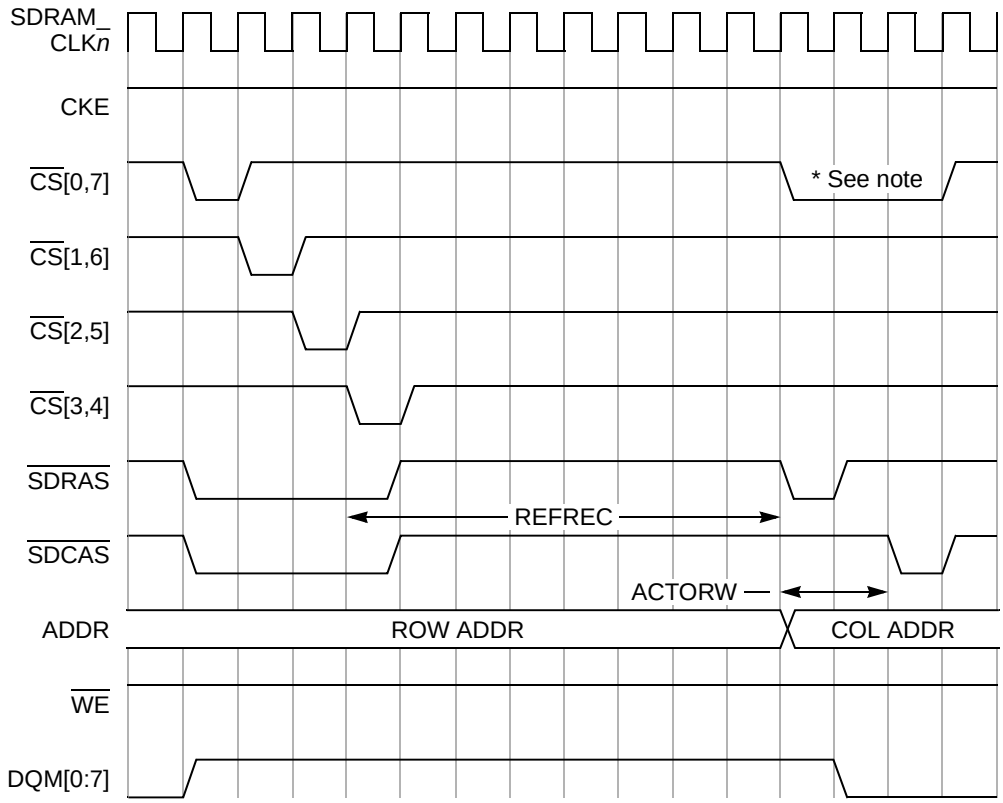
REFINT < 1027.237 – 11 – (211÷16) = 1003 clock cycles (rounded down)

The value stored in REFINT would be 0b00_0011_1110_1011 (or 1003 clock cycles).

6.2.12.1 SDRAM Refresh Timing

The CBR refresh timing for SDRAM is controlled by the programmable timing parameter MCCR3[REFREC]. REFREC represents the number of clock cycles from the refresh command until a bank-activate command is allowed. The AC specifications of the specific SDRAM device provides a minimum refresh-to-activate interval.

The MPC8245 implements bank staggering for CBR refreshes, as shown in Figure 6-17. This reduces instantaneous current consumption for memory refresh operations.



NOTE: Only one $\overline{CS}$ signal is asserted for the bank-activate and read commands.

Figure 6-17. SDRAM Bank Staggered CBR Refresh Timing

6.2.12.2 SDRAM Refresh and Power-Saving Modes

The MPC8245's memory interface provides for sleep, doze, and nap power-saving modes defined for the local processor architecture. See Chapter 15, "Power Management," for more information on these modes.

In doze and nap power-saving modes, the MPC8245 supplies normal CBR refresh to SDRAM. In sleep mode, the MPC8245 can be configured to use the SDRAM self-refresh mode, provide normal refresh to SDRAM, or provide no refresh support. If the MPC8245 is configured to provide no refresh support in sleep mode, system software is responsible for appropriately preserving SDRAM data, such as by copying to disk.

Table 6-14 summarizes the MPC8245 configuration bits relevant to power-saving modes.

Table 6-14. SDRAM Controller Power-Saving Configurations

Power-Saving Mode	Configuration Bits And Signal Values	Refresh Type	Refresh Configuration Bit Settings
Sleep	PMCR1[PM] = 1 PMCR1[SLEEP] = 1	Self	PMCR1[LP_REF_EN] = 1, MEMCFG[SREN] = 1
		Normal	PMCR1[LP_REF_EN] = 1, MEMCFG[SREN] = 0
		None	PMCR1[LP_REF_EN] = 0
Nap	PMCR1[PM] = 1 PMCR1[SLEEP] = 0 PMCR1[NAP] = 1	Normal	No additional bits required
Doze	PMCR1[PM] = 1 PMCR1[SLEEP] = 0, PMCR1[NAP] = 0, PMCR1[DOZE] = 1	Normal	No additional bits required

Table 6-15 summarizes the refresh types available in each power-saving mode and the relevant configuration parameters.

Table 6-15. SDRAM Power-Saving Modes Refresh Configuration

Power-Saving Mode	Refresh Type	Power Management Control Register (PMCR1)					MCCR1 [SREN]
		PM	DOZE	NAP	SLEEP	LP_REF_EN	
Doze	Normal	1	1	0	0	—	—
Nap	Normal	1	—	1	0	—	—
Sleep	Self	1	—	—	1	1	1
	Normal	1	—	—	1	1	0

The entry timing for self-refreshing SDRAMs is shown in Figure 6-18.

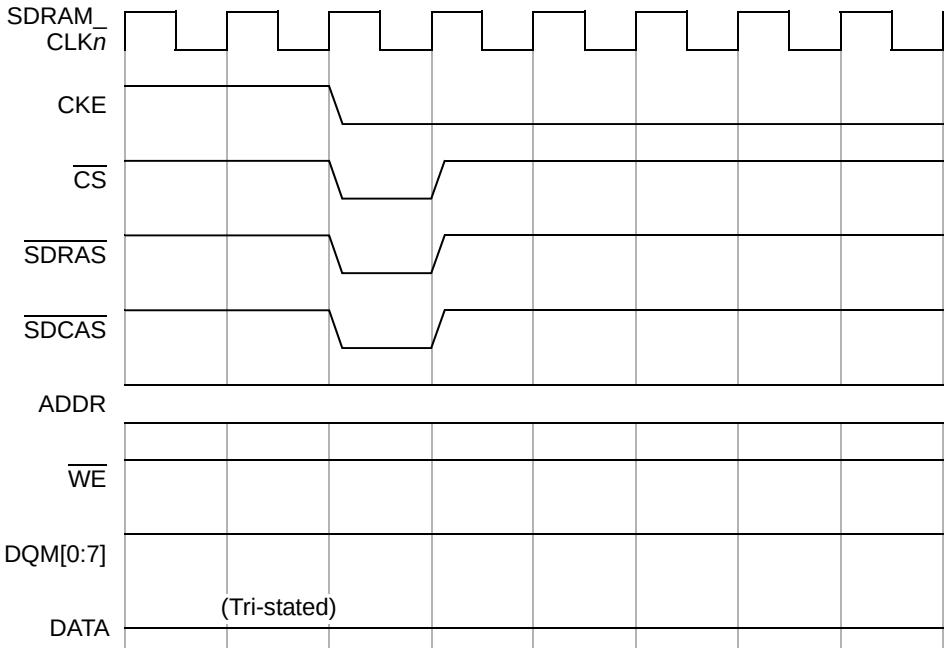


Figure 6-18. SDRAM Self-Refresh Entry

The exit timing for self-refreshing SDRAMs is shown in Figure 6-19.

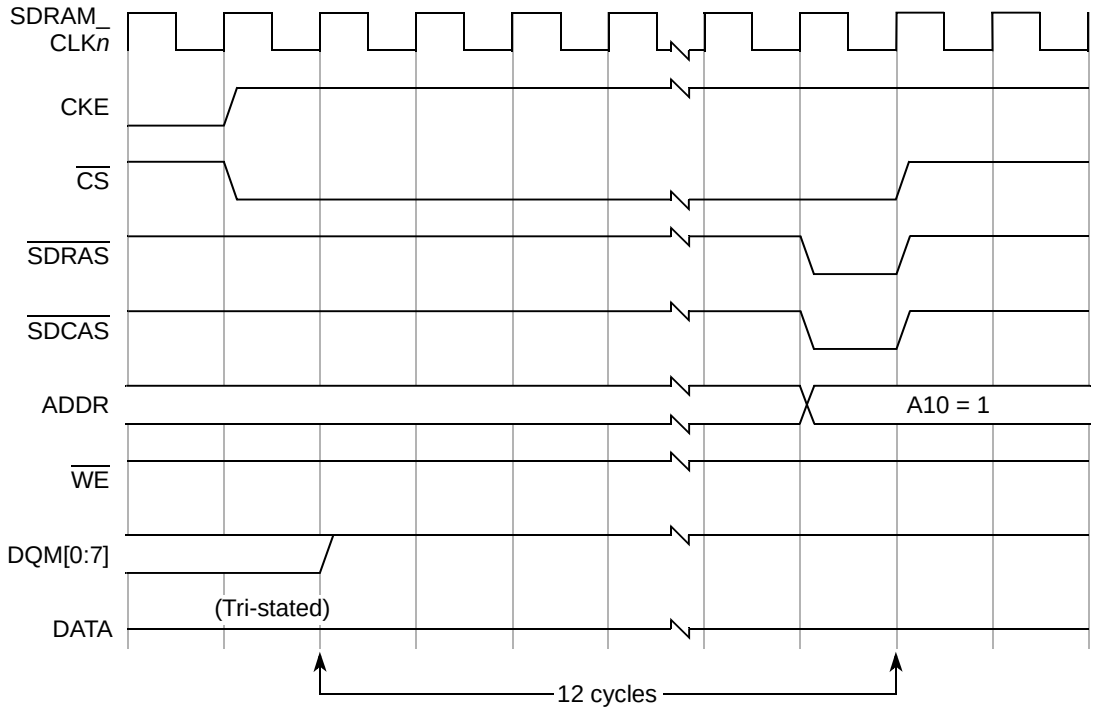


Figure 6-19. SDRAM Self-Refresh Exit

6.2.13 Processor-to-SDRAM Transaction Examples

The figures in this section provide examples of signal timing for 60x processor-to-SDRAM transactions. Figure 6-20 and Figure 6-21 show series of processor burst and single-beat reads to SDRAM. Figure 6-22 and Figure 6-23 show series of processor burst and single-beat writes to SDRAM. Figure 6-24 shows a series of processor single-beat reads followed by writes to SDRAM.

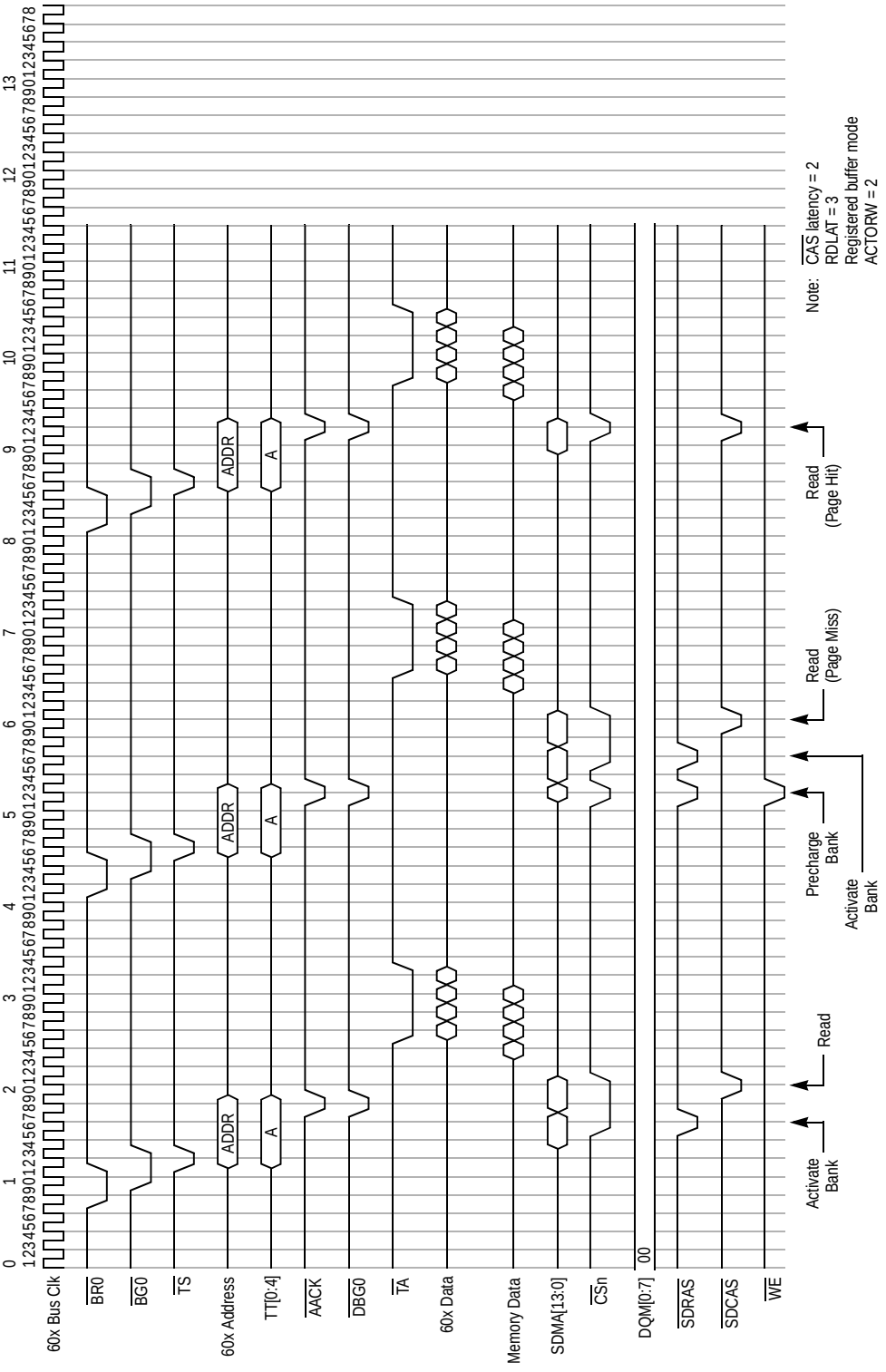


Figure 6-20. Processor Burst Reads from SDRAM

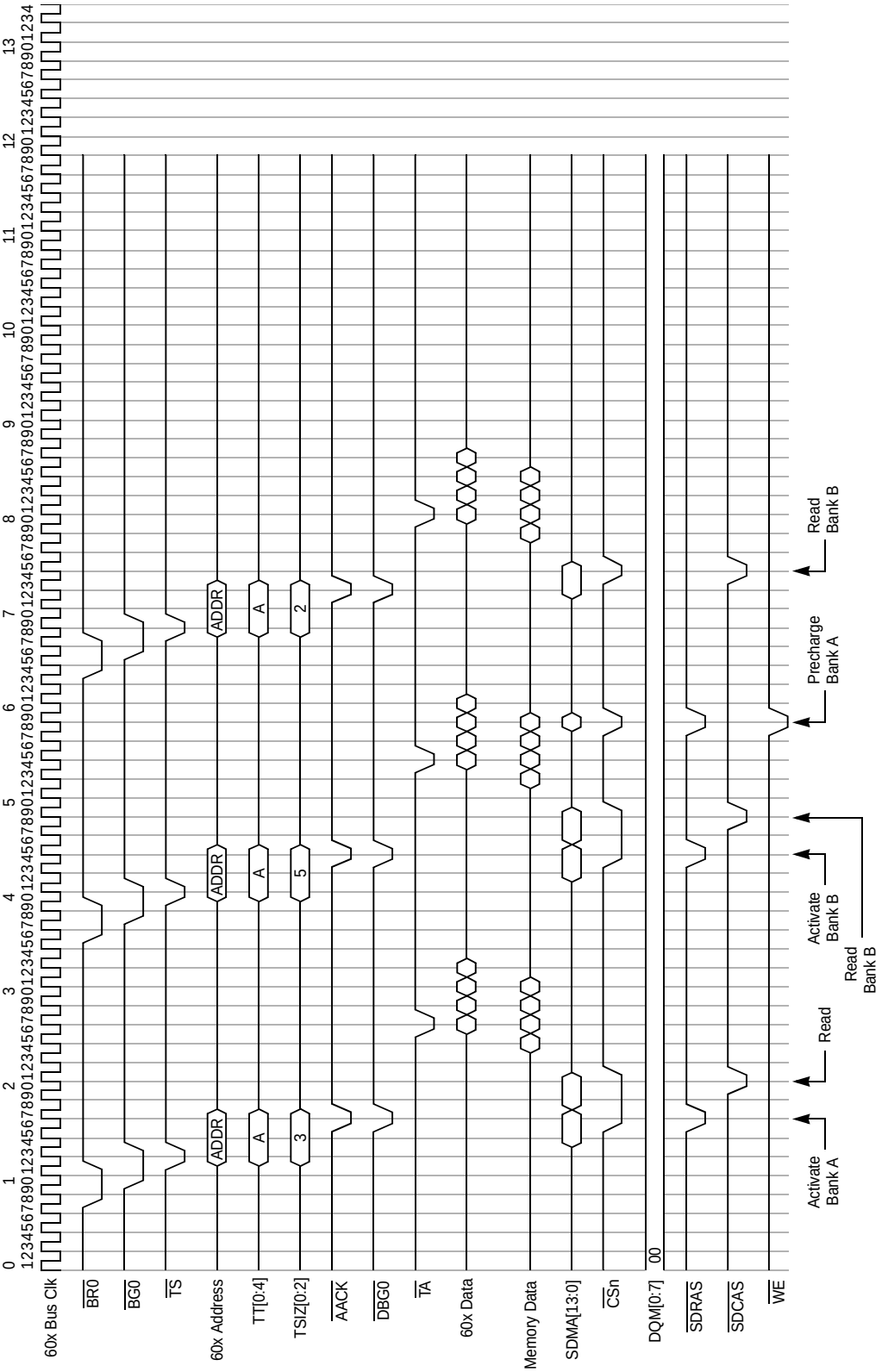


Figure 6-21. Processor Single-Beat Reads from SDRAM

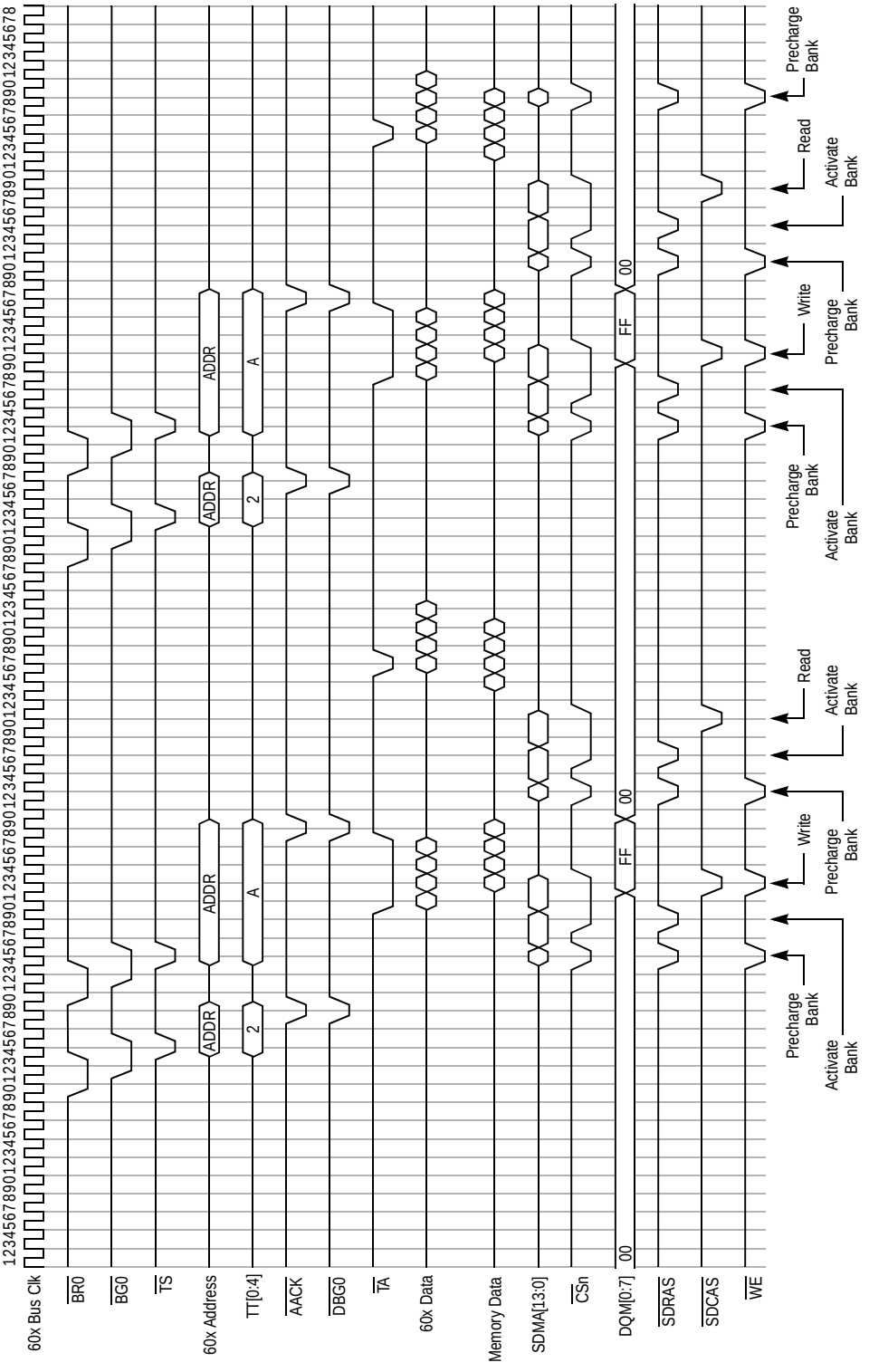


Figure 6-22. Processor Burst Writes to SDRAM

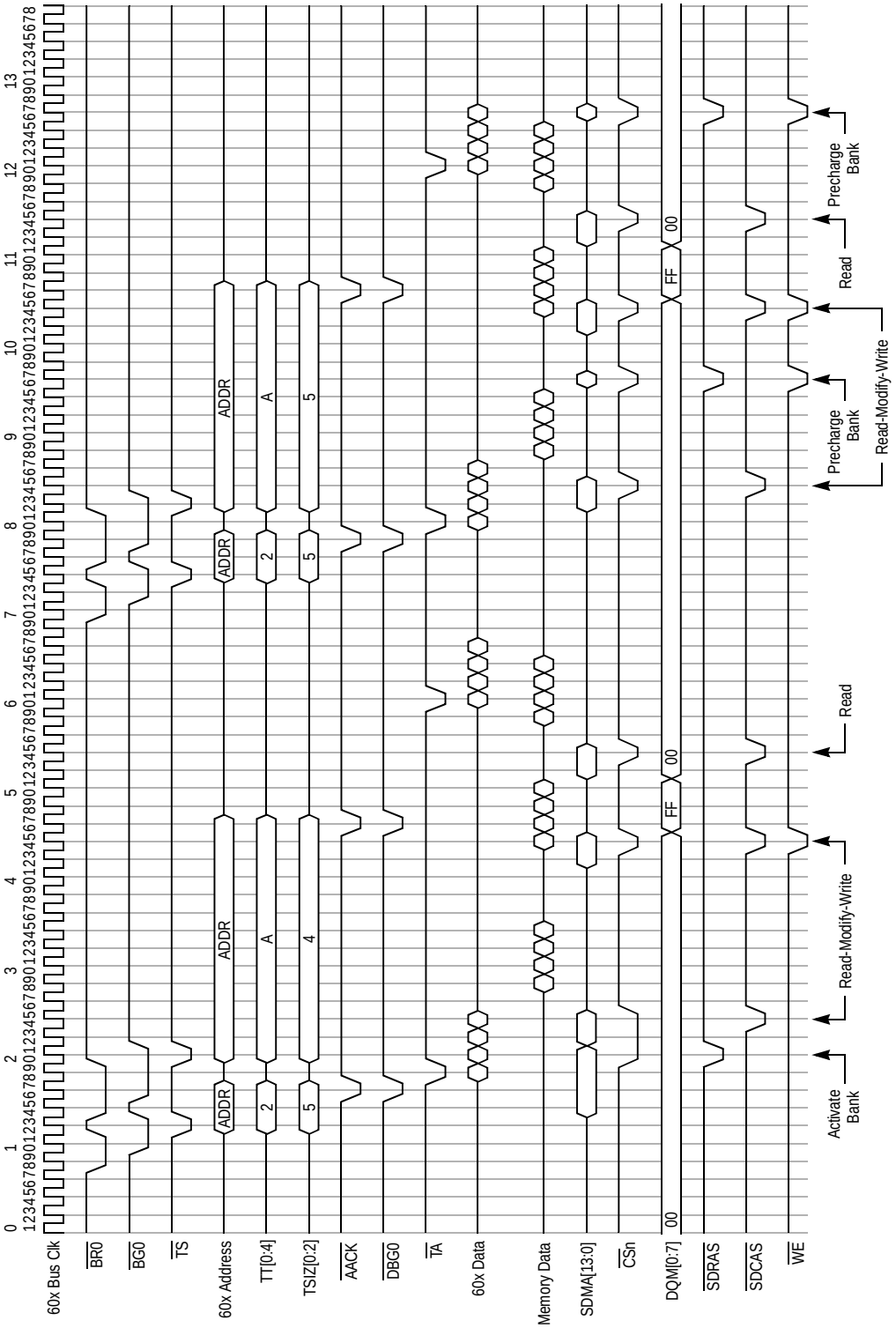


Figure 6-23. Processor Single-Beat Writes to SDRAM

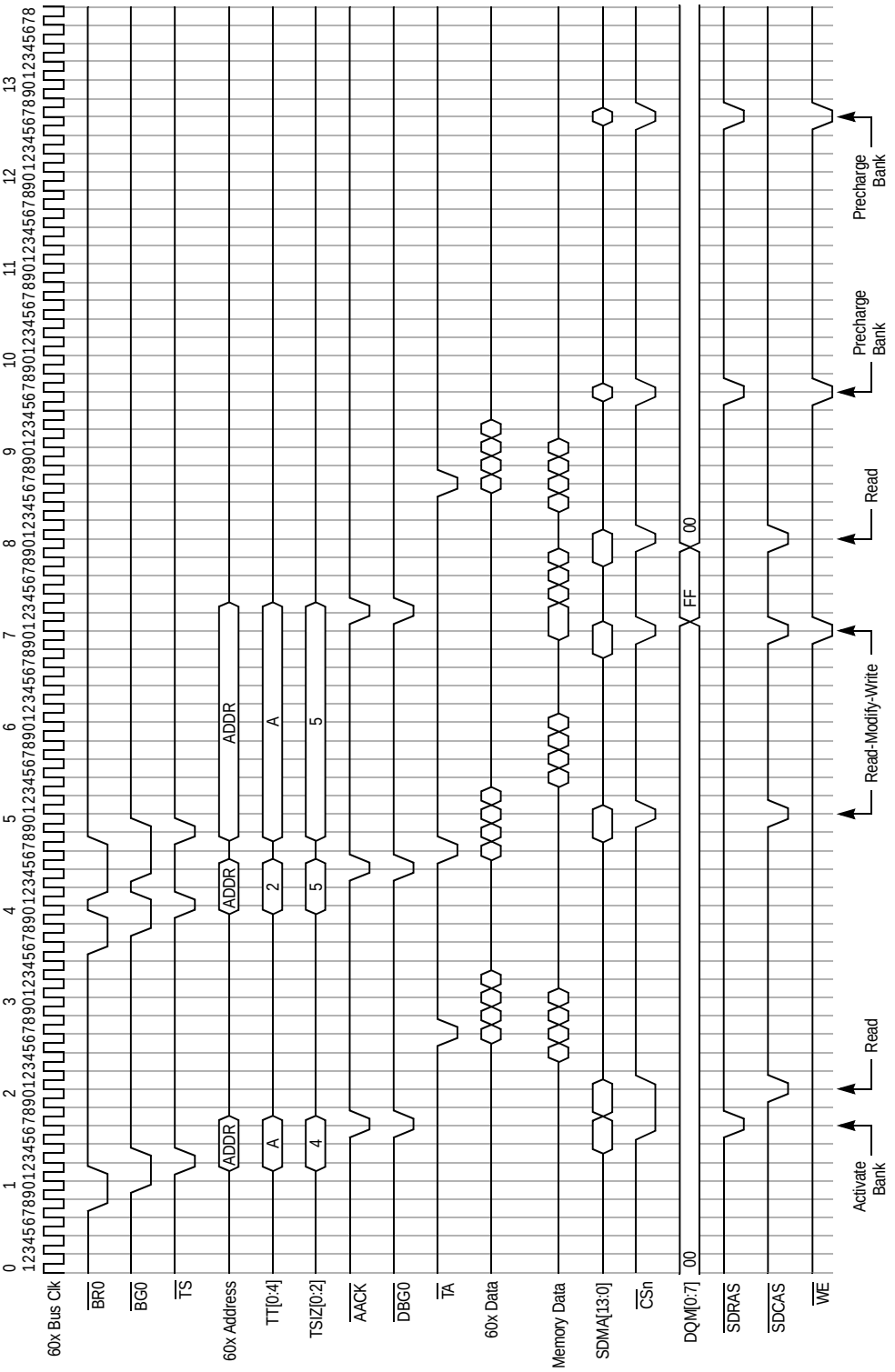


Figure 6-24. Processor Single-Beat Reads Followed by Writes to SDRAM

6.2.14 PCI-to-SDRAM Transaction Examples

The figures in this section provide examples of signal timing for PCI-to-SDRAM transactions. Figure 6-25 shows a series of PCI reads from SDRAM with speculative reads enabled. Figure 6-26 shows a series of PCI reads from SDRAM with speculative reads disabled. Figure 6-27 shows a series of PCI writes to SDRAM.

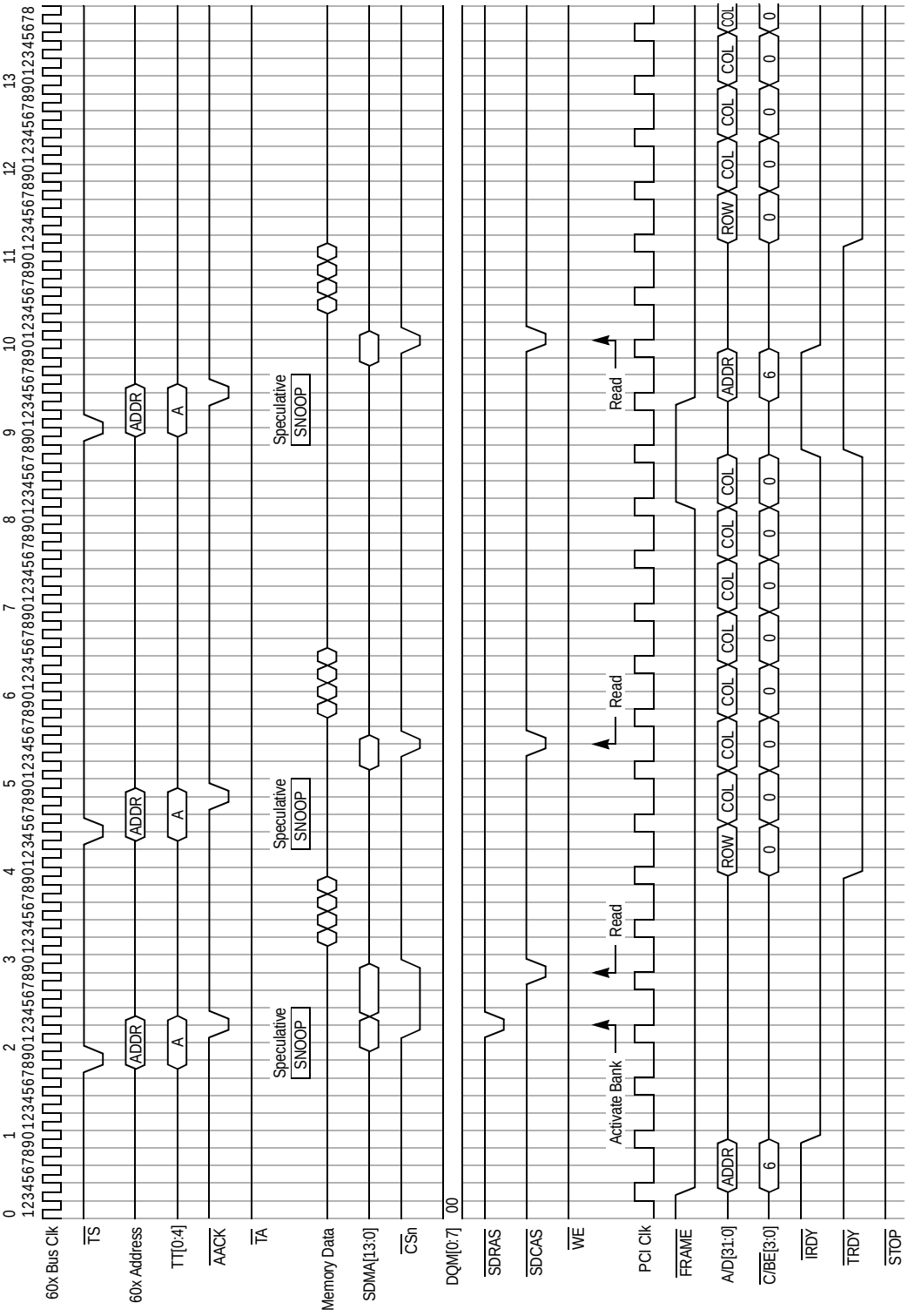


Figure 6-25. PCI Reads from SDRAM-Speculative Reads Enabled

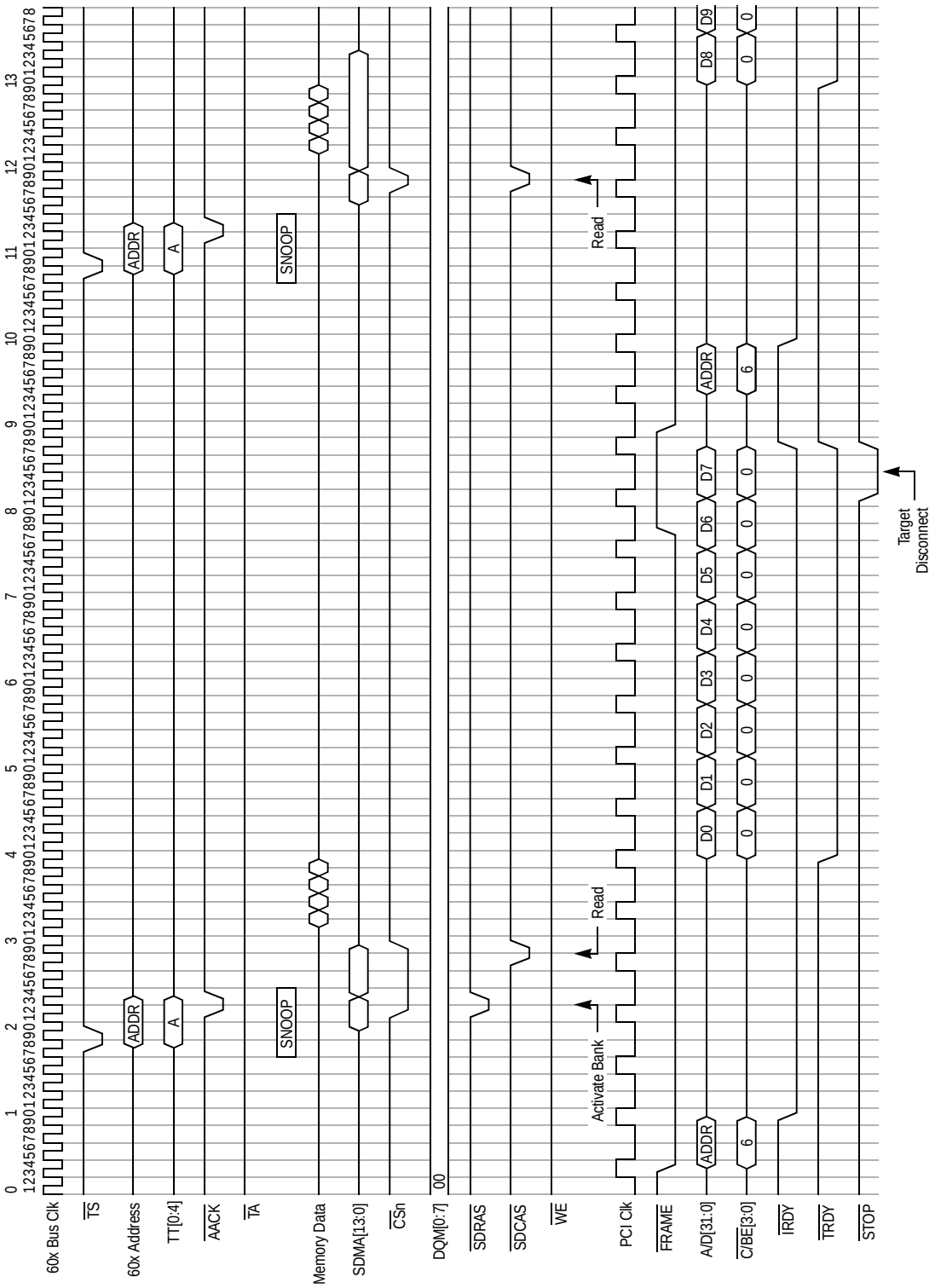


Figure 6-26. PCI Reads from SDRAM-Speculative Reads Disabled

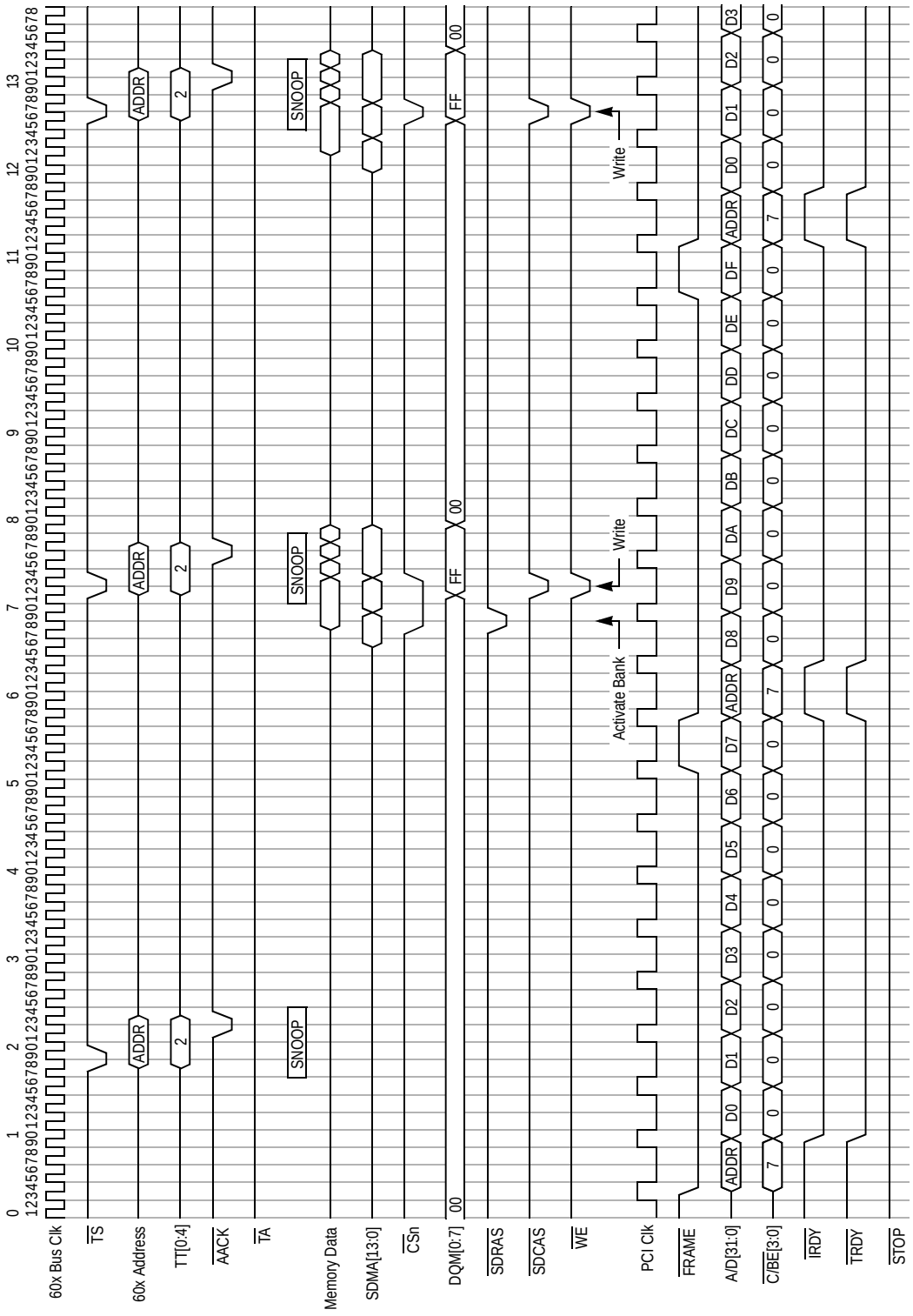


Figure 6-27. PCI Writes to SDRAM

6.3 ROM/Flash Interface Operation

The ROM/Flash interface of the MPC8245 controls two areas of memory: base ROM space, which is a 16-Mbyte area from 0xFF00_0000 to 0xFFFF_FFFF and extended ROM space, which is a 256-Mbyte area from 0x7000_0000 to 0x7FFF_FFFF.

The MPC8245 provides address, data, and control signals to interface to commonly available ROM and Flash devices. In addition to the ROM/Flash signals, the MPC8245 provides address strobe ($\overline{AS}$) and data ready ($\overline{DRDY}$) signals that permit interfacing to general I/O devices on the ROM interface. When configured to use the $\overline{AS}$ or $\overline{DRDY}$ signaling protocols, the ROM interface is referred to as Port X, signifying its generic I/O port functionality.

Figure 6-28 displays a block diagram of the ROM/Flash interface.

Figure 6-28. ROM Memory Interface Block Diagram

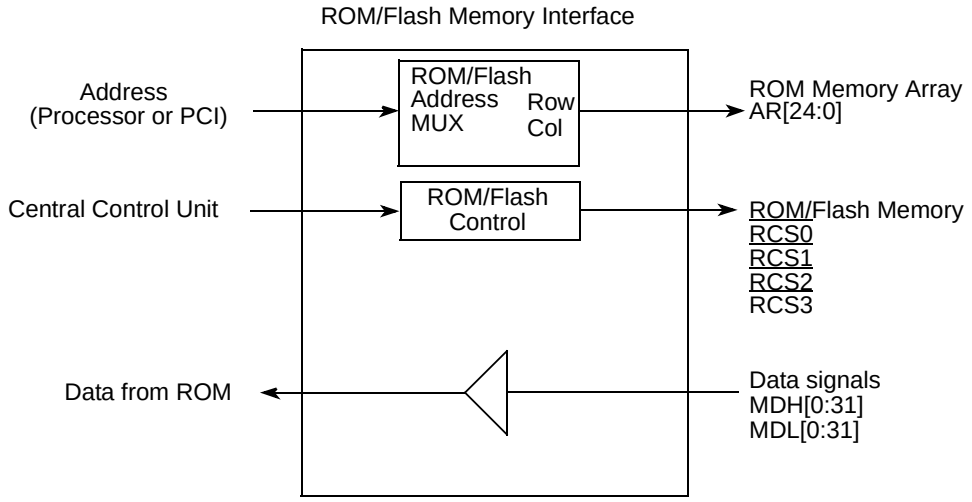
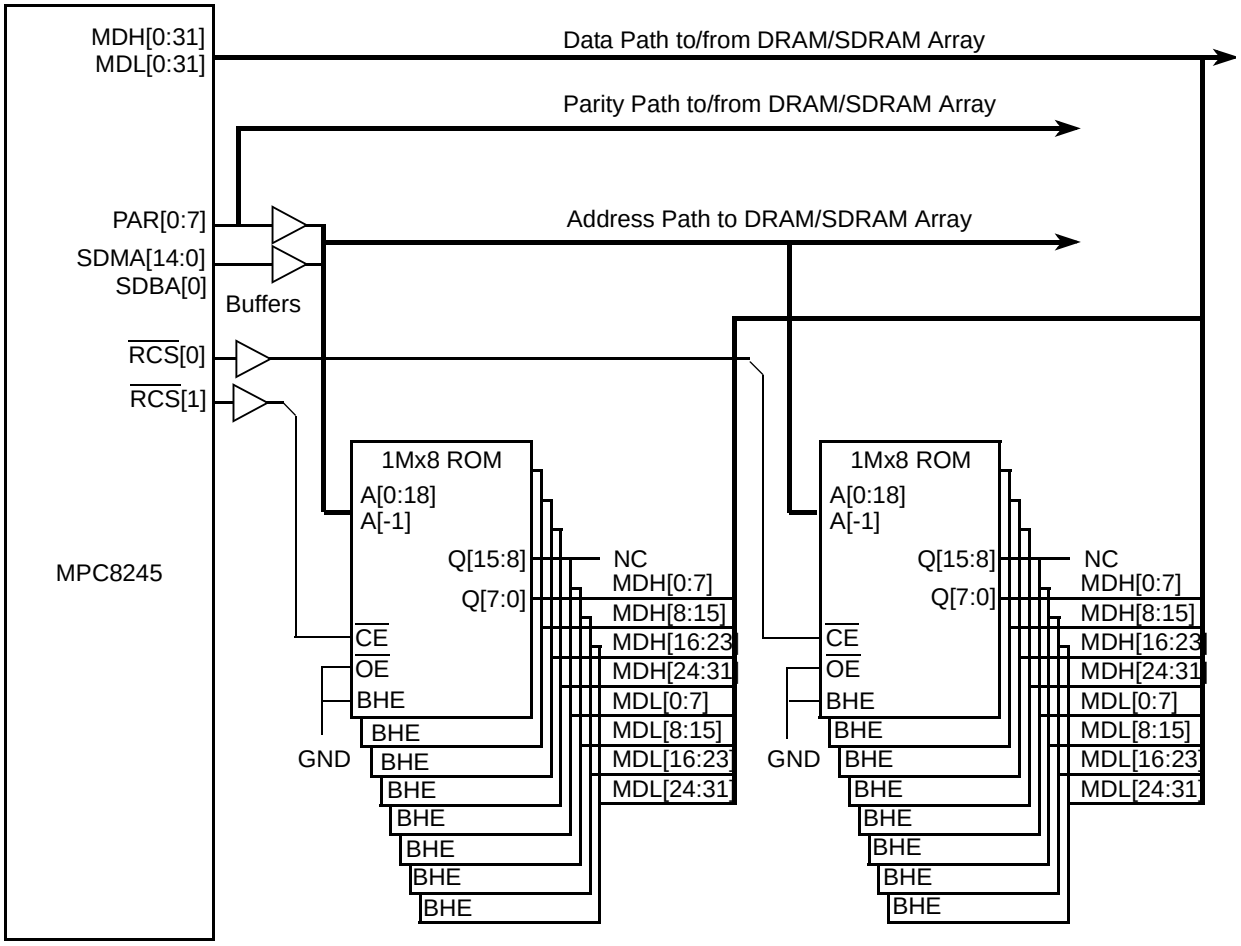


Figure 6-29 shows an example of a 16-Mbyte ROM system.



Notes:
1. The array of ROM memory devices are 8-Mbit (1M x 8 or 512K x 16) configured for 1M x 8 operation.
2. A[-1] is the lsb of the ROM memory devices.
3. BHE connected to GND enables A[-1] as an input and sets Q[15:8] to Hi-Z.
4. Q[7:0] of the ROM Memory devices are data outputs connected to MDH[0-31] and MDL[0:31]. MDH[0:7] is the most significant byte lane and MDL[24:31] is the least significant byte lane.
5. All $\overline{OE}$ and BHE signals are connected to GND.
6. $\overline{RCS}0$ is connected to all $\overline{CE}$ in Bank 0 (8 Mbytes) and $\overline{RCS}1$ is connected to all $\overline{CE}$ in Bank 1 (8 Mbytes).

Figure 6-29. 16-Mbyte ROM System Including Parity Paths to DRAM—64-Bit Mode

Figure 6-30 shows an example of a 2-Mbyte Flash system.

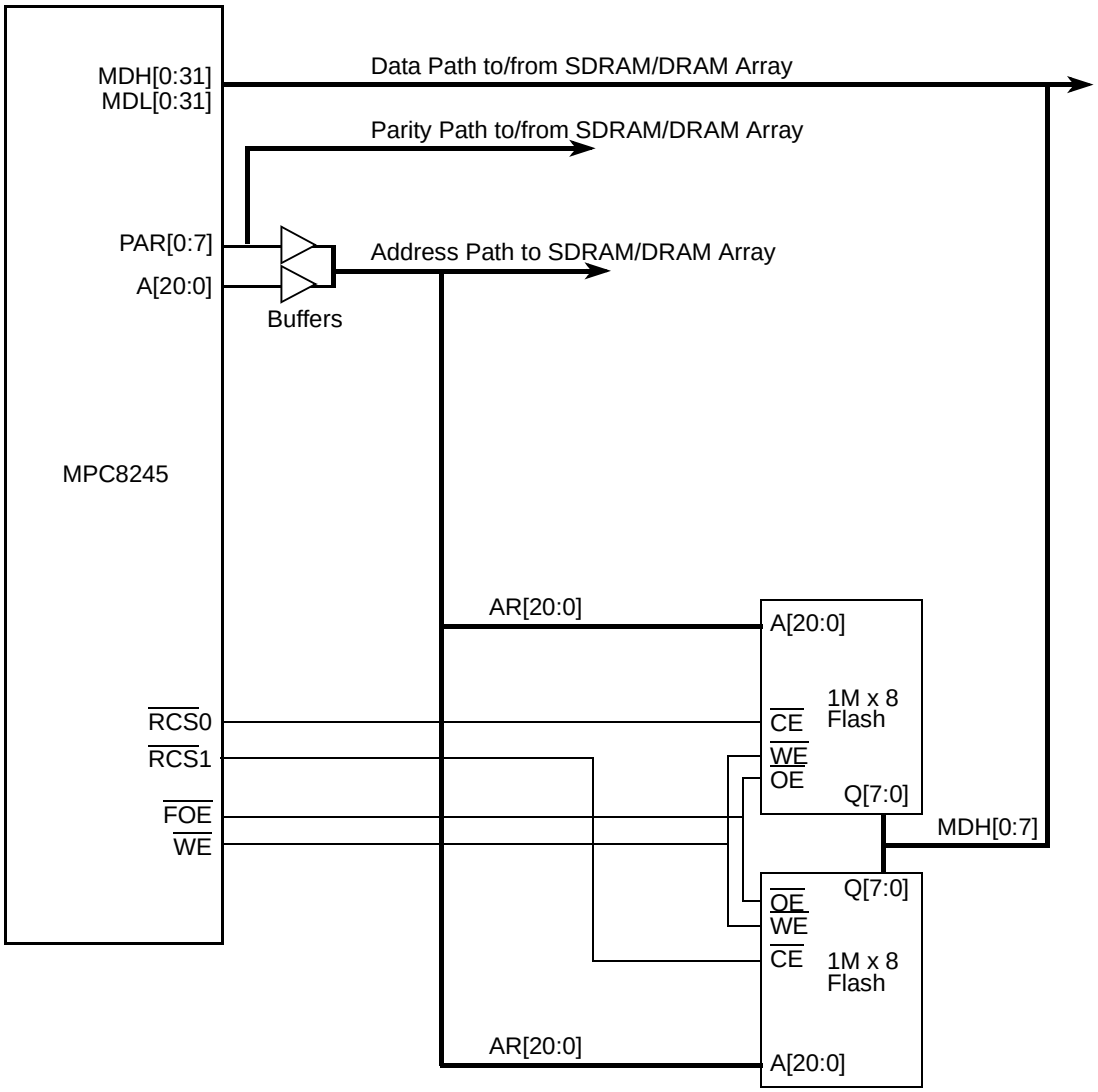


Figure 6-30. 2-Mbyte Flash Memory System Including Parity Paths to DRAM—8-Bit Mode

The following sections describe the operation of the base ROM, extended ROM, and Port X interfaces.

6.3.1 Base ROM Interface Operation

The 16-Mbyte base ROM/Flash space is subdivided into two 8-Mbyte banks. Bank 0 (selected by $\overline{\text{RCS0}}$) is addressed from 0xFF80_0000 to 0xFFFF_FFFF; bank 1 (selected by $\overline{\text{RCS1}}$) is addressed from 0xFF00_0000 to 0xFF7F_FFFF. In addition to the two chip selects ($\overline{\text{RCS0}}$ and $\overline{\text{RCS1}}$), an output enable ($\overline{\text{FOE}}$) and a write enable ($\overline{\text{WE}}$) provide the necessary control signals for the ROM or Flash devices.

The data bus width for each bank in base ROM space can be either 8-bits wide or the same width as the path to SDRAM (32- or 64-bits). The SDRAM data bus width is determined by the MDL[0] configuration signals that is sampled at reset. The $\overline{\text{FOE}}$ configuration signal determines the data bus width for bank 0 (8-bit or 32-/64-bit). The programmable parameter MCCR4[DBUS_SIZE2] determines the data bus width for bank 1.

For systems using the 8-bit interface, the ROM/Flash device must be connected to the most-significant byte lane of the data bus MDH[0:7]. The MPC8245 performs byte-lane alignment for single-byte reads from ROM/Flash memory. The MPC8245 can also perform byte gathering for up to 8 bytes for ROM/Flash read operations. The data bytes are gathered and aligned within the MPC8245, and then forwarded to the local processor.

Addressing for the base ROM space depends on the data bus width. For a 64-bit data path, the MPC8245 uses 20 ROM address bits; for a 32-bit data path, the MPC8245 uses 21 ROM address bits. This provides for up to 8 Mbytes of addressing for each base ROM chip select ($\overline{\text{RCS0}}$ and $\overline{\text{RCS1}}$) signal.

For the 8-bit data path, the MPC8245 uses either 22 or 23 address bits depending on the state of the SDMA1 signal at reset. If extended addressing mode is disabled (SDMA1 high at reset), the 8-bit interface uses 22 address bits and can only address 4 Mbytes for the associated chip select; if extended addressing mode is enabled (SDMA1 low at reset), the 8-bit interface uses 23 address bits and can address 8 Mbytes for the associated chip select.

Table 6-16 summarizes the address and data bus width configurations available on the base ROM interface. Note that DBUS_SIZE0 and DBUS_SIZE1 are sampled at reset on the configuration signals MDL[0] and FOE respectively. DBUS_SIZE2 and EXTROM are set by software during initialization.

Table 6-16. Base ROM Address and Data Bus Configurations

DBUS_SIZE[0–2]			SDRAM data bus width	Bank 0 (RCS0)	Bank 1 (RCS1)
MDL[0]	FOE	MCCR4 [DBUS_SIZE2]			
0	0	0	32 bits	32-bit interface 21 address bits 8-Mbyte space	32-bit interface 21 address bits 8-Mbyte space
0	0	1	32 bits	32-bit interface 21 address bits 8-Mbyte space	8-bit interface 22 or 23 address bits [1] 4- or 8-Mbyte space[1]
0	1	0	32 bits	8-bit interface 22 or 23 address bits[1] 4- or 8-Mbyte space[1]	32-bit interface 21 address bits 8-Mbyte space
0	1	1	32 bits	8-bit interface 22 or 23 address bits[1] 4- or 8-Mbyte space[1]	8-bit interface 22 or 23 address bits[1] 4- or 8-Mbyte space[1]

Table 6-16. Base ROM Address and Data Bus Configurations (continued)

DBUS_SIZE[0–2]			SDRAM data bus width	Bank 0 (RCS0)	Bank 1 (RCS1)
MDL[0]	FOE	MCCR4 [DBUS_SIZE2]			
1	0	0	64 bits	64-bit interface 20 address bits 8-Mbyte space	64-bit interface 20 address bits 8-Mbyte space
1	0	1	64 bits	64-bit interface 20 address bits 8-Mbyte space	8-bit interface 22 or 23 address bits[1] 4- or 8-Mbyte space[1]
1	1	0	64 bits	8-bit interface 22 or 23 address bits[1] 4- or 8-Mbyte space[1]	64-bit interface 20 address bits 8-Mbyte space
1	1	1	64 bits	8-bit interface 22 or 23 address bits[1] 4- or 8-Mbyte space[1]	8-bit interface 22 or 23 address bits[1] 4- or 8-Mbyte space[1]

[1] For the 8-bit interface, the setting of the SDMA1 signal at reset determines whether 22 or 23 address bits are used to provide 4 or 8 Mbytes of addressable space.

Implementations that require less than 16 Mbytes may allocate the required ROM/Flash to one or both banks. For example, an implementation that requires only 4 Mbytes of ROM/Flash could locate the ROM/Flash entirely within bank 0 at addresses 0xFFC0_0000–0xFFFF_FFFF. Alternately, the ROM/Flash could be split across both banks with 2 Mbytes in bank 0 at 0xFFE0_0000–0xFFFF_FFFF and 2 Mbytes in bank 1 at 0xFF60_0000–0xFF7F_FFFF. Any base ROM space that is not physically implemented within a bank is aliased to any physical device within that bank.

The MPC8245 can be configured to support ROM/Flash devices located on the memory bus or on the PCI bus. The $\overline{\text{RCS0}}$ signal is sampled at reset to determine the location of base ROM/Flash. If the base ROM space is mapped to the PCI bus, the MPC8245 translates all base ROM accesses as PCI memory transactions. In this case, the MPC8245 does not supply the ROM control, address, and data signals from its ROM interface.

The MPC8245 also supports splitting the base ROM space between PCI and the local memory bus. The entire base ROM space is mapped to the PCI space; then, by setting the configuration parameter PICR2[CF_FF0_LOCAL], the lower half of the base ROM space (0xFF00_0000–0xFF7F_FFFF) is remapped onto the local memory bus. This allows the system to have the upper half of base ROM space on the PCI bus for boot firmware and the lower half of the base ROM space on the local memory bus for performance critical firmware. The ROM/Flash on the local memory bus is selected by $\overline{\text{RCS1}}$.

6.3.1.1 Base ROM Address Multiplexing

When the physical address for an access is 0xFF*nn_nnnn* and the base ROM space is mapped to the local bus, the MPC8245 decodes bit A[8] of the physical address to

determine which chip select to assert. If A[8] = 0b1, the MPC8245 asserts $\overline{\text{RCS0}}$; if A[8] = 0b0, the MPC8245 asserts $\overline{\text{RCS1}}$. The remaining physical address bits are multiplexed onto the ROM address signals according to the following figures.

Base ROM address multiplexing for the 8-bit data path is shown in Figure 6-31.

MPC8245 Output Signals	Physical Address																								
	0-8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
SDMA		12	11											10	9	8	7	6	5	4	3	2	1	0
SDBA				1									0											
PAR					0	1	2	3	4	5	6	7												
Logical Names																								
AR		22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0

Figure 6-31. Base ROM Address Multiplexing—8-Bit Data Path

For Figure 6-31, note that AR[22] is only provided to the 8-bit base ROM interface if SDMA1 is sampled low at reset. See Section 6.3.1, “Base ROM Interface Operation,” for more information.

Base ROM address multiplexing for the 32-bit data path is shown in Figure 6-32.

MPC8245 Output Signals	Physical Address																							
	0-8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
SDMA												10	9	8	7	6	5	4	3	2	1	0		
SDBA		1									0													
PAR			0	1	2	3	4	5	6	7														
Logical Names																								
AR		20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		

Figure 6-32. Base ROM Address Multiplexing—32-Bit Data Path

Base ROM address multiplexing for the 64-bit data path is shown in Figure 6-33.

MPC8245 Output Signals	Physical Address																							
	0-8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
SDMA											10	9	8	7	6	5	4	3	2	1	0			
SDBA										0														
PAR		0	1	2	3	4	5	6	7															
Logical Names																								
AR		19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			

Figure 6-33. Base ROM Address Multiplexing—64-Bit Data Path

6.3.2 Extended ROM Interface

At power-on reset, the 256-Mbyte extended ROM space is disabled. The extended ROM interface is optional and must be first enabled by pulling the SDMA1 signal low at reset, to enable extended addressing mode, and setting MCCR4[EXTROM]. Once enabled, the extended ROM space is accessed by CPU or PCI memory transactions to physical addresses from 0x7000_0000 to 0x7FFF_FFFF. Note that extended addressing mode also effects base ROM addressing in 8-bit mode. See Section 6.3.1, “Base ROM Interface Operation,” for more information.

Like the base ROM interface, the extended ROM space is divided between two banks selected by $\overline{\text{RCS2}}$ and $\overline{\text{RCS3}}$; however, the extended ROM space does not have fixed addresses associated with each bank. Instead, the two banks have programmable starting addresses within the extended ROM space with sizes programmable from 4 Kbytes to 128 Mbytes. Note that each bank must be individually enabled using ERCR1[RCS2_EN] for the bank controlled by $\overline{\text{RCS2}}$ and ERCR2[RCS3_EN] for the bank controlled by $\overline{\text{RCS3}}$. In addition to the two chip selects ($\overline{\text{RCS2}}$ and $\overline{\text{RCS3}}$), an output enable signal ($\overline{\text{FOE}}$) and a write enable signal ($\overline{\text{WE}}$) provide the necessary controls for ROM or Flash devices in extended ROM space.

The banks are configured using four extended ROM configuration registers, ERCR1, ERCR2, ERCR3, and ERCR4. See Section 4.9, “Extended ROM Configuration Registers—0xD0, 0xD4, 0xD8, 0xDC,” for more information. ERCR1 and ERCR3 configure the $\overline{\text{RCS2}}$ interface and ERCR2 and ERCR4 configure the $\overline{\text{RCS3}}$ interface. Individual parameters in these sets of registers are similar, so the notation RCS*n_param* is used in this section where *n* is 2 or 3 depending on the specific chip select and *param* is the specific parameter. The MPC8245 provides the following extended ROM parameters:

- RCS*n*_EN: Enables or disables the extended ROM banks independently

- RCS*n*_BURST: Supports burst-mode ROM devices
- Extended ROM interface timing controls (including RCS*n*_CTL, RCS*n*_ROMFAL, RCS*n*_NAL, RCS*n*_ASFALL, RCS*n*_ASRISE, and RCS*n*_TS_WAIT_TIMER): control the timing of each extended ROM bank. See Section 6.3.4, “ROM Interface Timing,” and Section 6.3.5, “Port X Interface,” for more information.
- RCS*n*_DBW: Determines the width of the data path for each extended ROM bank
- RCS*n*_SADDR: Determines the starting address of each extended ROM bank.
- RCS*n*_SIZE: Determines the size of each extended ROM bank

The data bus width for each bank in extended ROM space can be 8, 16, or 32 bits with read gathering, or an extended ROM bank can use same data bus width as the path to SDRAM (32- or 64-bits wide, depending on the MDL[0] configuration signal that is sampled at reset). ERCR1[RCS2_DBW] determines the data bus width for bank 2; ERCR2[RCS3_DBW] determines the data bus width for bank 3.

For systems using an 8-bit interface, the ROM/Flash device must be connected to the most-significant byte lane of the data bus MDH[0:7]. For systems using a 16-bit interface, the ROM/Flash device(s) must be connected to the two most-significant byte lanes of the data bus MDH[0:15]. For systems using a 32-bit interface (gathering or non-gathering), the ROM/Flash devices must be connected to the four most-significant byte lanes of the data bus MDH[0:31]. For systems using a 64-bit (wide) interface, the ROM/Flash devices are connected to all byte lanes of the data bus MDH[0:31] and MDL[0:31].

The starting address of each extended ROM banks is restricted to the address range from 0x7000_0000 to 0x7FFF_FFFF. In addition, the two extended ROM banks must not be programmed to overlap.

Addressing for the extended ROM space depends on the data bus width and the bank size programmed in RCS*n*_SIZE. The MPC8245 can provide up to 25 ROM address bits for the extended ROM interface. This means that for an 8-bit data path, the bank size is limited to 32 Mbytes; for a 16-bit data path, the bank size is limited to 64 Mbytes; and for a 32-bit data path, the bank size is limited to 128 Mbytes. Because the RCS*n*_SIZE parameter is limited to a 128-Mbyte maximum, the 64-bit data path only supports 24 ROM address bits.

Table 6-17 summarizes the address and data bus configurations available on the extended ROM interface.

Table 6-17. Extended ROM Address and Data Bus Configurations

MDL[0]	SDRAM data bus width	RCS*n*_DBW	Bank *n* (RCS*n*)
—	—	00	8-bit interface 25 address bits 32-Mbytes maximum
—	—	01	16-bit interface 25 address bits 64-Mbytes maximum
—	—	10	32-bit gathering interface 25 address bits 128-Mbytes maximum
0	32 bits	11	32-bit non-gathering (wide) interface 25 address bits 128-Mbytes maximum
1	64 bits	11	64-bit (wide) interface 24 address bits 128-Mbytes maximum

6.3.2.1 Extended ROM Address Multiplexing

When the physical address for an access is 0x7*nnn_nnnn* and the extended ROM space is enabled (EXT_ROM = 0b1), the MPC8245 compares the higher order bits of the physical address to the values in RCS*n*_SADDR to determine which chip select to assert. The specific extended ROM bank must be enabled and the physical address must fall within the bank size specified by RCS*n*_SIZE before the MPC8245 asserts the corresponding chip select. Once the bank enable and size is checked, the physical address bits are multiplexed onto the ROM address signals according to the following figures.

Extended ROM address multiplexing for the 8-bit data path is shown in Figure 6-34.

MPC8245 Output Signals	Physical Address																												
	0-6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
SDMA		14	13	12	11											10	9	8	7	6	5	4	3	2	1	0
SDBA						1									0											
PAR							0	1	2	3	4	5	6	7												
Logical Names																										
AR		24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0

Figure 6-34. Extended ROM Address Multiplexing—8-Bit Data Path

Extended ROM address multiplexing for the 16-bit data path is shown in Figure 6-35.

MPC8245 Output Signals	Physical Address																												
	0-5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
SDMA		14	13	12	11											10	9	8	7	6	5	4	3	2	1	0	
SDBA						1									0												
PAR							0	1	2	3	4	5	6	7													
Logical Names																											
AR		24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	

Figure 6-35. Extended ROM Address Multiplexing—16-Bit Data Path

Extended ROM address multiplexing for the 32-bit data path is shown in Figure 6-36.

MPC8245 Output Signals	Physical Address																													
	0-4	**5**	**6**	**7**	**8**	**9**	**10**	**11**	**12**	**13**	**14**	**15**	**16**	**17**	**18**	**19**	**20**	**21**	**22**	**23**	**24**	**25**	**26**	**27**	**28**	**29**	**30**	**31**
SDMA		14	13	12	11											10	9	8	7	6	5	4	3	2	1	0		
SDBA						1									0													
PAR							0	1	2	3	4	5	6	7														
Logical Names																												
AR		24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		

Figure 6-36. Extended ROM Address Multiplexing—32-Bit Data Path

Extended ROM address multiplexing for the 64-bit data path is shown in Figure 6-37.

MPC8245 Output Signals	Physical Address																													
	0-4	**5**	**6**	**7**	**8**	**9**	**10**	**11**	**12**	**13**	**14**	**15**	**16**	**17**	**18**	**19**	**20**	**21**	**22**	**23**	**24**	**25**	**26**	**27**	**28**	**29**	**30**	**31**
SDMA		13	12	11											10	9	8	7	6	5	4	3	2	1	0			
SDBA					1									0														
PAR						0	1	2	3	4	5	6	7															
Logical Names																												
AR		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			

Figure 6-37. Extended ROM Address Multiplexing—64-Bit Data Path

6.3.2.2 Extended ROM Interface Read Gathering

For the 8-bit base and extended ROM interfaces, the MPC8245 performs byte-lane alignment for single-byte reads from ROM/Flash memory. The MPC8245 performs byte gathering for up to eight bytes for ROM/Flash read operations. The data bytes are gathered and aligned within the MPC8245, and then forwarded to the processor core.

For the 16-bit extended ROM interface, the MPC8245 performs halfword data alignment for single-halfword reads from ROM/Flash memory. The MPC8245 performs halfword gathering for up to four halfwords for ROM/Flash read operations. The halfwords are gathered and aligned within the MPC8245, and then forwarded to the processor core.

For the 32-bit gathering extended ROM interface, the MPC8245 performs word alignment for single-word reads from ROM/Flash memory. The MPC8245 performs word gathering for up to two words for ROM/Flash read operations. The data bytes are gathered and aligned within the MPC8245, and then forwarded to the processor core.

6.3.3 ROM/Flash Interface Write Operations

PICR1[FLASH_WR_EN] must be set for write operations to ROM/Flash memory space (base and extended). FLASH_WR_EN controls whether write operations to ROM/Flash memory are allowed. FLASH_WR_EN is cleared at reset to disable write operations to ROM/Flash memory. Note that MCCR1[MEMGO] must be set before any writes to Flash are attempted. System logic is responsible for multiplexing any required high voltages to Flash memory devices for write operations.

Writes to ROM/Flash can be locked out by setting PCIR2 [FLASH_WR_LOCKOUT]. When this bit is set, the MPC8245 disables writing to the ROM/Flash memory areas (base and extended), even if FLASH_WR_EN is set. Once set, the FLASH_WR_LOCKOUT parameter can be cleared only by a hard reset.

The MPC8245 accommodates only single-beat datapath-sized (8-, 32-, or 64-bit depending on the configuration) writes to Flash memory. PICR1[NO_BUS_WIDTH_CHECK] controls whether the MPC8245 checks the data path size of processor writes to local base ROM space. If NO_BUS_WIDTH_CHECK is set, an attempt to write to Flash in extended ROM space with a transfer size other than the base ROM data bus size (for example, a 32-bit write to an 8-bit Flash) does not cause a Flash write error. If NO_BUS_WIDTH_CHECK is cleared, an attempt to write to Flash with a transfer size other than the base ROM data bus size causes a Flash write error. If an attempt is made to write to Flash with a transfer size other than the extended ROM data bus size, the MPC8245 does not report an error. In either case, if software is writing to Flash, the write operations should be sized to the data-path width (8, 16, 32, or 64 bits) because only a single write enable ($\overline{WE}$) strobe is available.

If the system attempts to write to read-only devices in a bank, bus contention may occur because the write data is driven onto the data bus when the read-only device is also trying to drive its data onto the data bus. This situation can be avoided by disabling writes to the ROM/Flash space using FLASH_WR_EN or FLASH_WR_LOCKOUT or by connecting the ROM/Flash output enable ($\overline{FOE}$) signal to the output enable on the read-only device.

6.3.4 ROM Interface Timing

The MPC8245 provides programmable access timing for the ROM/Flash interface so that systems of various clock frequencies and devices with distinct AC timing requirements can be implemented.

When the 64- or 32-bit (wide) data path is used, the MPC8245 can be configured to take advantage of burst (or nibble) mode access time improvements, which are available with some ROM devices. The MPC8245 implements a BURST parameter to enable or disable burst-mode timing. Both of the base ROM banks use the same BURST parameter in the MCCR1. For the extended ROM banks, each bank has a bank-specific BURST parameter in the associated ERCR. Burst-mode timing is disabled at reset; the BURST bit must be set by initialization code. The 8-, 16-, and 32-bit gathering interfaces cannot support devices that use burst-mode timing.

The MPC8245 uses three parameters to control the ROM access timing for a given bank: ROMFAL, ROMNAL, and TS_WAIT_TIMER. As shown in Table 6-18, both of the base ROM banks use the same base ROM timing parameters in the MCCRs. For the extended ROM banks, each bank can be configured to use either bank-specific timing parameters specified in the ERCR1 and ERCR2 or use the base ROM timing parameters specified in the MCCRs. RCS*n*_CTL selects which timing parameters are used for the associated extended ROM bank.

Table 6-18. ROM Timing Configuration Parameters

ROM Timing Parameter	Base ROM	Extended ROM	
	Banks 0 and 1 ($\overline{RCS}$[0:1])	Bank 2 ($\overline{RCS2}$) RCS2_CTL ≠ 0b01 [1]	Bank 3 ($\overline{RCS3}$) RCS3_CTL ≠ 0b01[1]
ROMFAL	MCCR1[ROMFAL]	ERCR1[RCS2_ROMFAL]	ERCR2[RCS3_ROMFAL]
ROMNAL	MCCR1[ROMNAL]	ERCR1[RCS2_ROMNAL]	ERCR2[RCS3_ROMNAL]
TS_WAIT_TIMER	MCCR2[TS_WAIT_ TIMER]	ERCR1[RCS2_TS_WAIT_ TIMER]	ERCR2[RCS3_TS_WAIT_ TIMER]
BURST	MCCR1[BURST]	ERCR1[RCS2_BURST]	ERCR2[RCS3_BURST]

[1] If RCSn_CTL = 0b01 this bank will use the timing specified for base ROM

ROMFAL and ROMNAL are reset to their maximum values in order to accommodate initial boot code fetches. TS_WAIT_TIMER is set to its minimum value at reset. To improve performance, initialization software should program a more appropriate value for the device being used.

ROMFAL represents wait states in the read access time for non-burst-mode ROMs and also measures wait states for the first data beat from burst-mode ROMs. When the BURST parameter is cleared, all beats of a ROM read burst use the ROMFAL parameter to determine the read access time. The access time is ROMFAL + 3 clock cycles for 64-/32-bit (wide) read accesses and ROMFAL + 2 clock cycles for 8-, 16-, and 32-bit gathered read accesses. ROMFAL also controls the Flash memory write pulse low time (that is, the number of cycles that $\overline{WE}$ is held asserted during a write to Flash). As shown in Figure 6-44, the actual write pulse low count is two cycles more than the value specified in ROMFAL. For example, when ROMFAL = 0b00000, $\overline{WE}$ is asserted for 4 clock cycles;

when ROMNAL = 0b00001, $\overline{WE}$ is asserted for 5 clock cycles; when ROMNAL = 0b00010, $\overline{WE}$ is asserted for 6 clock cycles; and so on.

ROMNAL represents wait states in access time for the second and subsequent beats in a burst accesses to burst-mode ROM devices. The burst-mode access time is ROMNAL + 2 clock cycles. When the BURST parameter is set, only the first beat of the ROM read burst uses ROMFAL for access time wait states. ROMNAL also controls the Flash memory write recovery time (that is, the number of cycles between write pulse assertions). As shown in Figure 6-44, the actual write recovery cycle count is four cycles more than the value specified in ROMNAL. Note that the Flash write recovery timing is disabled for Port X devices in the extended ROM space for handshake and strobe modes.

TS_WAIT_TIMER represents wait states in the recovery time for ROM accesses. Some ROM/Flash/Port X devices require long output disable timing. To avoid contention, TS_WAIT_TIMER can be used to delay a subsequent transaction start on the local memory bus to allow the slow device to stop driving the data bus. The delay is enforced for all local memory accesses (SDRAM or ROM) after any access to ROM space. The default number of wait states is two clocks.

6.3.4.1 Read Timing—64-/32-Bit (Wide) Data Path

The following figures illustrate the 64-/32-bit (wide) ROM/Flash interface timing for various read accesses. Figure 6-38 shows a read access for a non-burst-mode ROM using the 64-/32-bit (wide) data path.

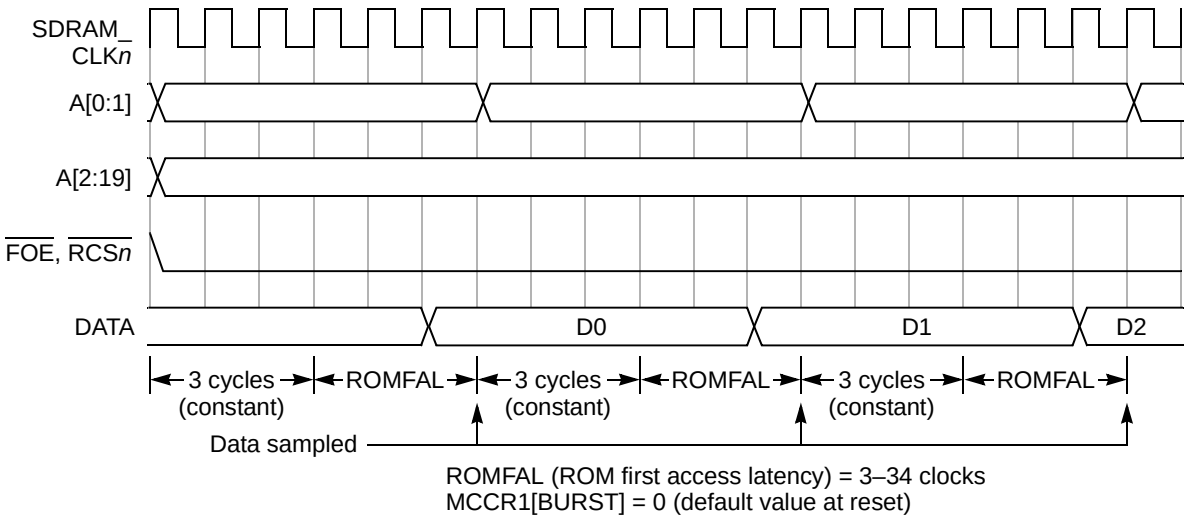


Figure 6-38. Read Access Timing for Non-Burst ROM/Flash Devices—64-/32-Bit (Wide) Data Path

Figure 6-39 shows a 4-beat read access for a burst-mode ROM using the 64-bit (wide) data path.

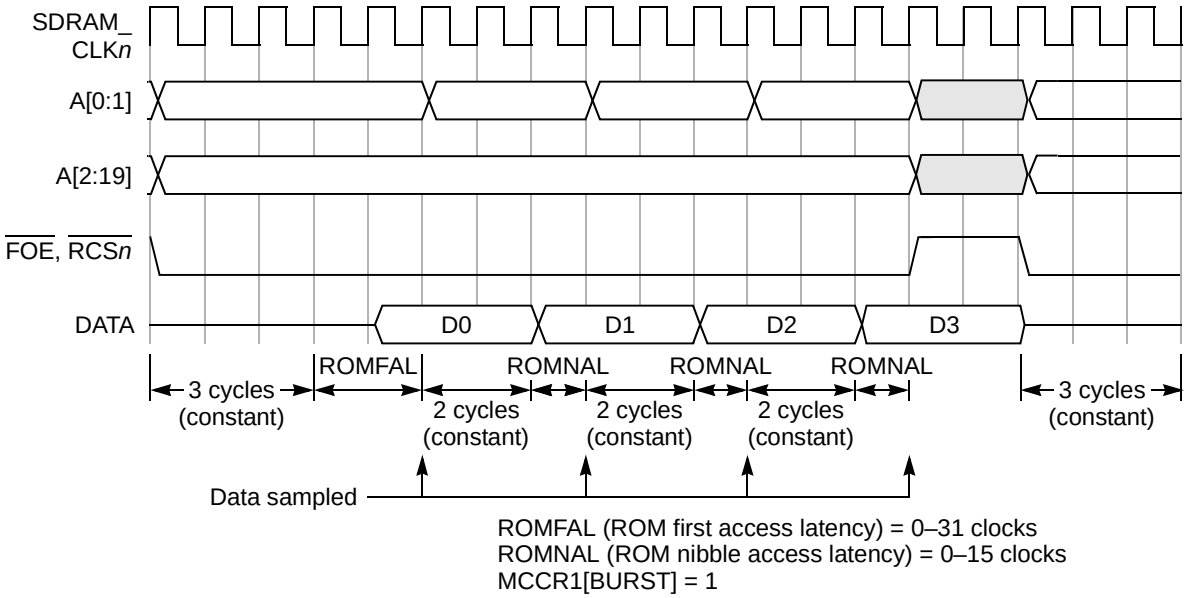


Figure 6-39. Read Access Timing (Cache Block) for Burst ROM/Flash Devices—64-Bit (Wide) Data Path

Figure 6-40 shows an 8-beat read access for a burst-mode ROM using the 32-bit (wide) data path.

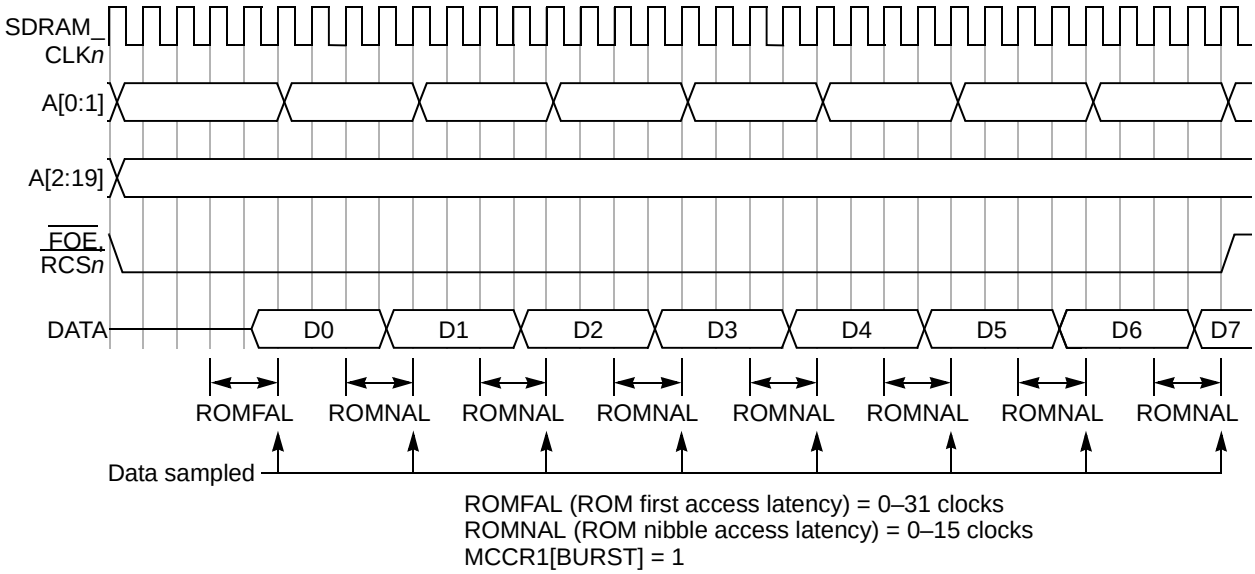


Figure 6-40. Read Access Timing (Cache Block) for Burst ROM/Flash Devices—32-Bit (Wide) Data Path

6.3.4.2 Read Timing—8-Bit Data Path

The following figures illustrate the 8-bit ROM/Flash interface timing for various read accesses. Figure 6-41 shows a single-byte read access for the 8-bit data path.

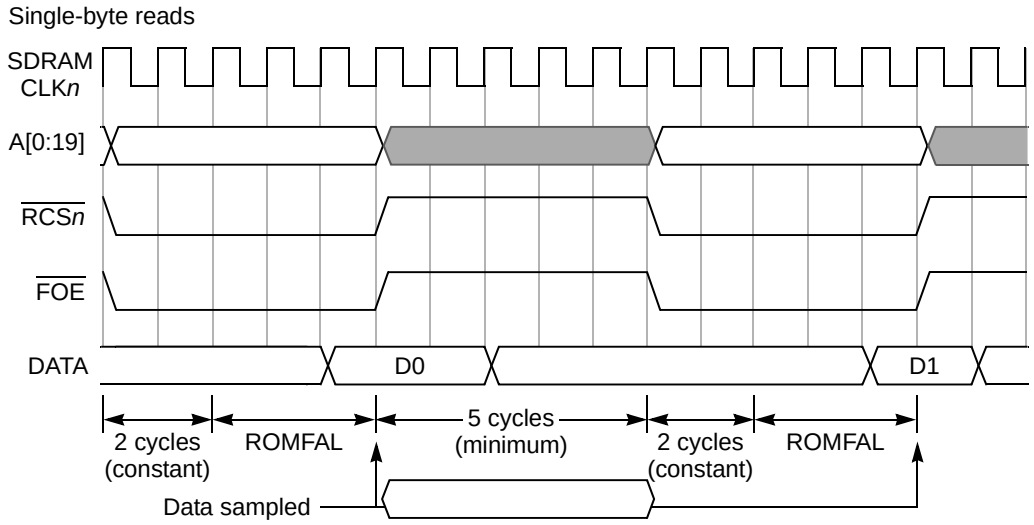


Figure 6-41. 8-Bit ROM/Flash Interface—Single-Byte Read Timing

Figure 6-42 shows a halfword read access for the 8-bit data path.

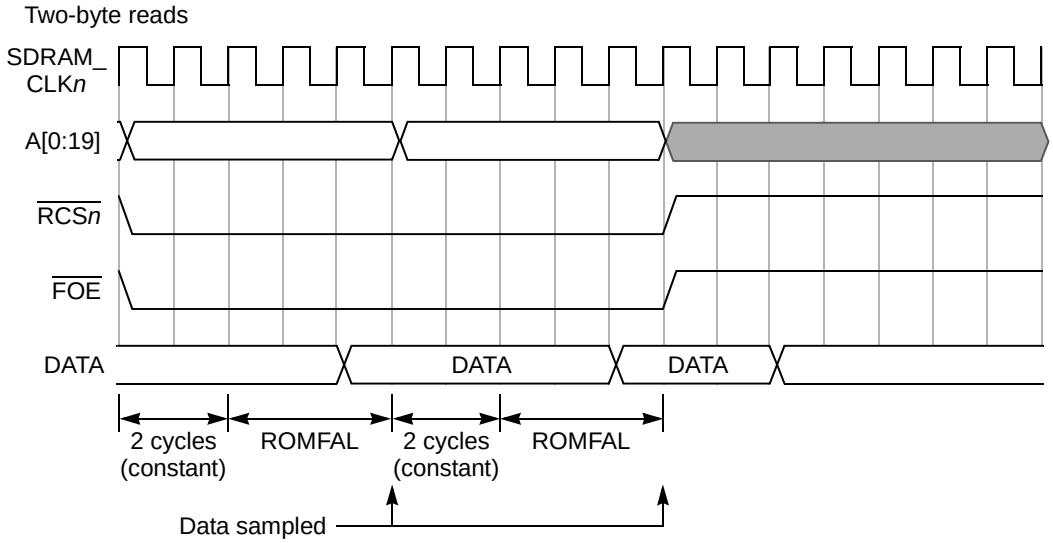


Figure 6-42. 8-Bit ROM/Flash Interface—Two-Byte Read Timing

Figure 6-43 shows a cache block read access for the 8-bit data path. Word and double-word accesses require using the cache-line read access timing shown in Figure 6-43.

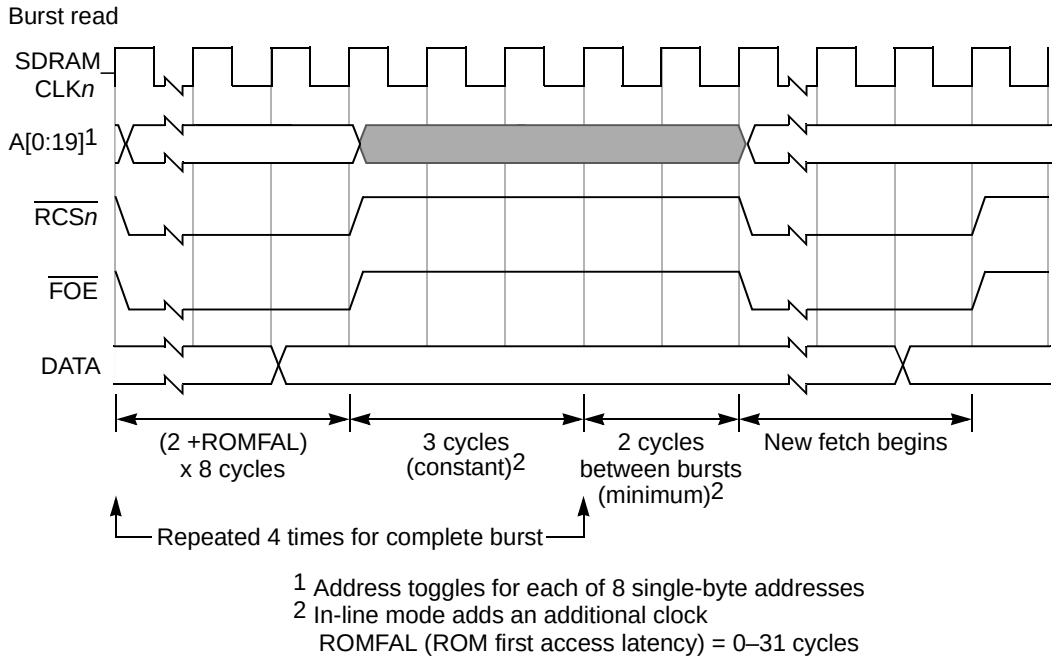


Figure 6-43. 8-Bit ROM/Flash Interface—Cache-Line Read Timing

The following paragraphs describe Figure 6-45 in details. Note that ‘a’ represents the actual data transaction and ‘b’ represents recovery:

1a) $\overline{\text{RCSn}}$ is asserted (low) for the 8 transfers needed to gather the first doubleword (8 bytes). The ROM address will increment every ROMFAL + 2 cycles.

1b) $\overline{\text{RCSn}}$ is negated (high) for 3 cycles for Registered Buffer Mode or 4 cycles for In-Line Buffer Mode.

2a) $\overline{\text{RCSn}}$ is asserted for the 8 transfers needed to gather the second doubleword.

2b) $\overline{\text{RCSn}}$ is negated for 3 or 4 cycles depending on the buffer mode (as above in 1b).

3a) $\overline{\text{RCSn}}$ is asserted for the 8 transfers needed to gather the third doubleword.

3b) $\overline{\text{RCSn}}$ is negated for 3 or 4 cycles, depending on the buffer mode (as above in 1b).

4a) $\overline{\text{RCSn}}$ is asserted for the 8 transfers needed to gather the fourth double.word.

4b) $\overline{\text{RCSn}}$ is negated for 5 cycles for Registered Buffer Mode (3+2) or 7 cycles for In-Line Buffer Mode (4+3).

6.3.4.3 ROM/Flash Interface Write Timing

Figure 6-44 shows the write access timing of the ROM/Flash interface.

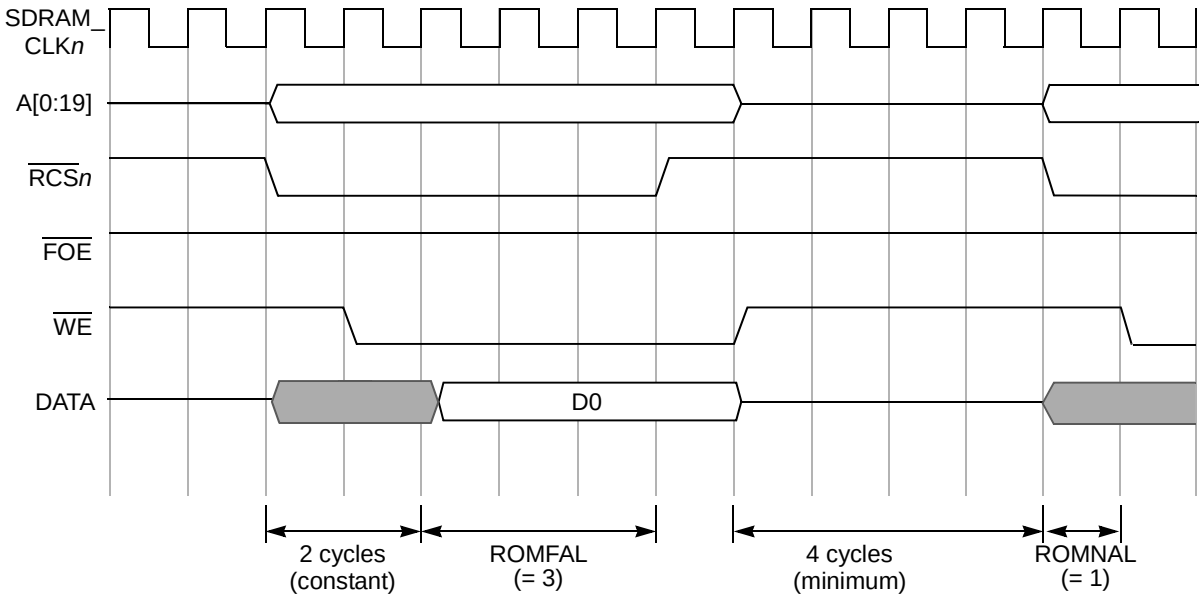


Figure 6-44. 8-, 16-, 32-, or 64-Bit Flash Write Access Timing

6.3.5 Port X Interface

The MPC8245's ROM/Flash interface is flexible enough to allow the system designer to connect other nonmemory devices to it. This functionality is called Port X, and this section describes this interface.

By enhancing the ROM/Flash interface with an address strobe ($\overline{AS}$) output signal, a data ready ($\overline{DRDY}$) input signal, and dedicated timing parameters, it is possible to access a wide range of I/O devices with the MPC8245. Note that Port X is strictly an enhancement of the ROM/Flash interface and is subject to the limitations of that interface.

Figure 6-45 shows a block diagram of the Port X Peripheral Interface.

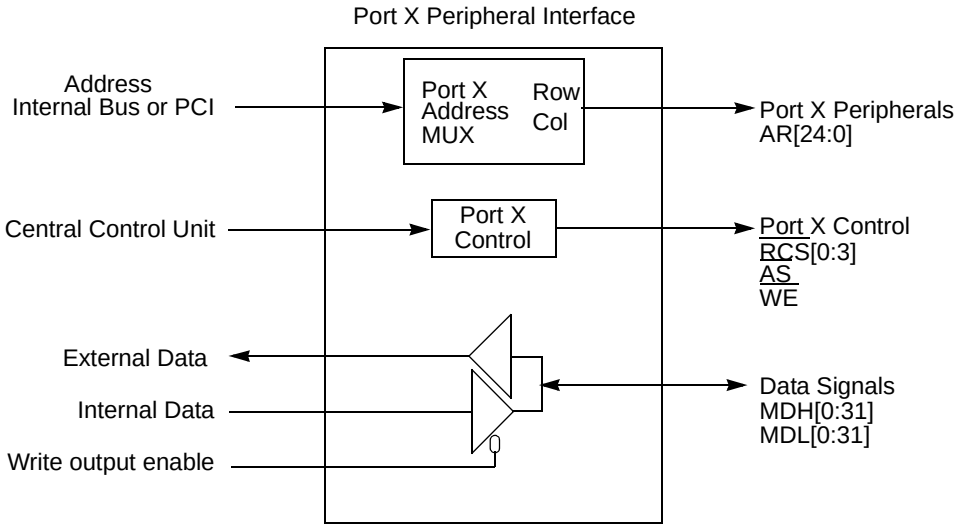


Figure 6-45. Port X Peripheral Interface Block Diagram

Figure 6-46 shows an example of a Port X implementation. Note that adding miscellaneous devices to the MPC8245 memory bus may limit the total number of memory devices or the maximum bus speed due to signal loading constraints and address space limitations.

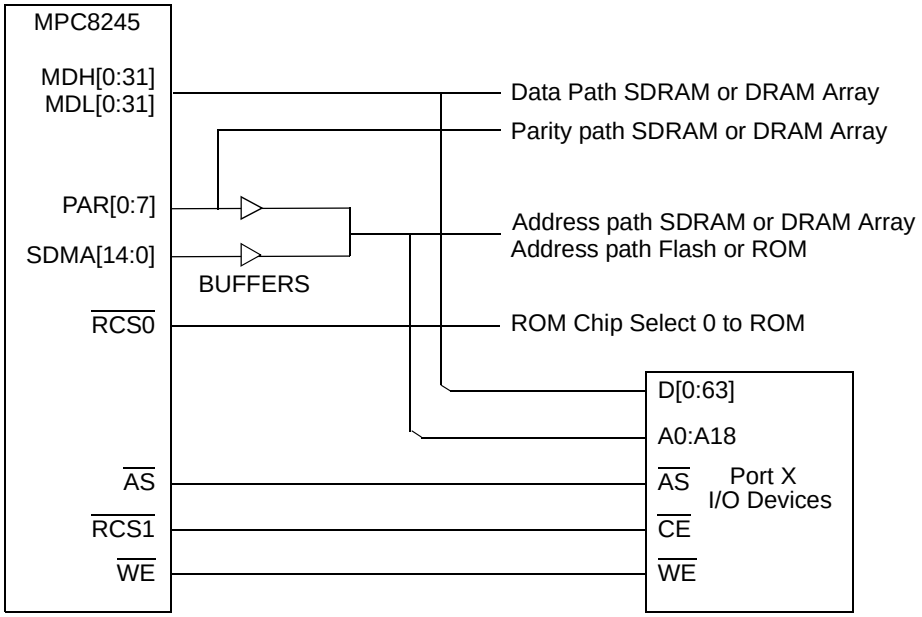


Figure 6-46. Example of Port X Peripheral Connected to the MPC8245

6.3.5.1 Port X Operation

The Port X interface shares the MPC8245 ROM/Flash interface state machine. This has the following consequences:

- Port X address space is exactly the same as ROM/Flash address space (that is, base ROM space and extended ROM space).
- Port X uses the same address multiplexing as the ROM/Flash interface.
- Data is provided on the data bus as with any ROM device.
- A Port X device has all the data-path options of the ROM interface: 8-, 16-, 32-, and 64-bits.
- The $\overline{\text{RCS}n}$, $\overline{\text{FOE}}$, and $\overline{\text{WE}}$ signals provide control for Port X devices.

Port X adds an address strobe output signal ($\overline{\text{AS}}$) and a data-ready input signal ($\overline{\text{DRDY}}$).

The $\overline{\text{AS}}$ signal has a programmable falling and rising edge to provide a latch strobe or edge reference to allow an external device to latch the data, address, or control signals from the memory interface signals. $\overline{\text{AS}}$ is driven active for all accesses to the base ROM address space (0xFF00_0000 to 0xFFFF_FFFF) and the extended ROM address space (0x7000_0000 to 0x7FFF_ FFFF). This allows a Port X device to be put on any of the four available chip selects without disturbing (or being disturbed by) memory devices sharing the memory interface address and control signals.

The $\overline{\text{DRDY}}$ signal is used for Port X strobe and handshake modes. These modes are available only to Port X devices in the extended ROM space. Port X strobe mode provides a way for fast Port X devices to terminate a Port X transaction early (see Section 6.3.5.3, “Port X Strobe Mode,” for more information); Port X handshake mode provides a way for slow Port X devices to delay the data tenure of a Port X transaction (see Section 6.3.5.4, “Port X Handshake Mode,” for more information).

PCI masters should not attempt to read from Port X devices in handshake or strobe mode.

The ROM/Flash controller is capable of multiple-beat read operations (that is, multiple data tenures for one address tenure). However, if a Port X device is accessed with a multiple-beat read operation, $\overline{\text{AS}}$ asserts and negates only once and not multiple times after $\overline{\text{RCS}n}$ asserts. Also note that PCI reads from Port X are always bursts filling one of the PCI-to-local-memory-read buffers (PCMRB).

Also, because the MPC8245 shares the Port X interface with the Flash interface, only single-beat writes to Port X are supported. Therefore, care must be taken if the Port X memory space is marked as cacheable (as burst writes for cache block castouts are not supported).

In some implementations, writes of data with a size other than the full data-path width may be desired. For example, a halfword write to a Port X device configured as 64-bits wide.The MPC8245 allows these transactions and does not report an error.

6.3.5.2 Port X Timing

In addition to the ROM access timing parameters described in Section 6.3.4, “ROM Interface Timing,” the MPC8245 uses two parameters to control the $\overline{AS}$ timing for a given bank, ASRISE and ASFALL. As shown in Table 6-19, both of the base ROM banks use the same $\overline{AS}$ timing parameters in the MCCR2. For the extended ROM banks, each bank can be configured to use either bank-specific $\overline{AS}$ timing parameters specified in the ERCR1 and ERCR2 or use the base ROM timing parameters specified in the MCCRs. RCS*n*_CTL selects which timing parameters are used for the associated extended ROM bank.

Table 6-19. Port X $\overline{AS}$ Timing Parameters

ROM Timing Parameter	Base ROM	Extended ROM	
	Banks 0 and 1 ($\overline{RCS[0:1]}$)	Bank 2 ($\overline{RCS2}$) RCS2_CTL ≠ 0b01 [1]	Bank 3 ($\overline{RCS3}$) RCS3_CTL ≠ 0b01[1]
ASRISE	MCCR2[ASRISE]	ERCR1[RCS2_ASRISE]	ERCR2[RCS3_ASRISE]
ASFALL	MCCR2[ASFALL]	ERCR1[RCS2_ASFALL]	ERCR2[RCS3_ASFALL]

[1] If RCSn_CTL = 0b01 this bank will use the $\overline{AS}$ timing specified for base ROM

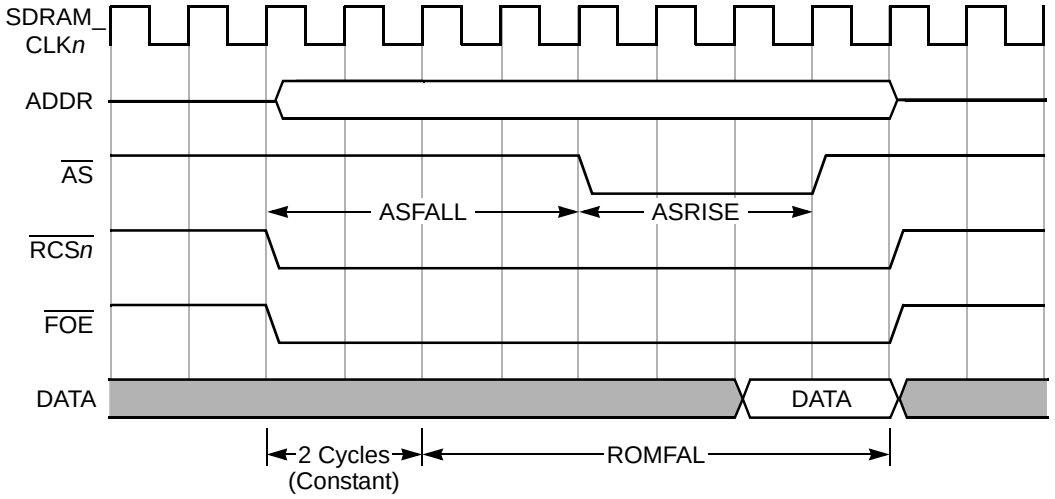
ASFALL controls when the $\overline{AS}$ signal is asserted relative to the assertion of $\overline{RCSn}$. If ASFALL is programmed to 0b00000, the $\overline{AS}$ pin is asserted in the same clock cycle that the associated chip-select is asserted. A value greater than zero adds a corresponding number of clock cycles from the assertion of $\overline{RCSn}$ to the assertion of $\overline{AS}$. For example, an ASFALL value of 0b0011 means that the $\overline{AS}$ signal is asserted three clock cycles after $\overline{RCSn}$ is asserted.

ASRISE controls how long $\overline{AS}$ is held asserted, or when the $\overline{AS}$ signal is negated relative to the assertion of $\overline{AS}$. For example, an ASRISE value of 0b0100 means that $\overline{AS}$ negates 4 clock cycles after it was asserted. Setting ASRISE to 0b0000 effectively disables $\overline{AS}$ and causes it to remain negated.

At reset, both ASRISE and ASFALL are initialized to 0.

Due to restrictions in the ROM/Flash controller, the ASFALL and ASRISE parameters should be programmed as ASRISE + ASFALL ≤ ROMFAL + 5 if the ROM interface is programmed to support the 8-, 16-, or 32-bit gathering data path. For the 64-/32-bit (wide) data path, ASFALL and ASRISE should be programmed as ASRISE + ASFALL ≤ ROMFAL + 6. Note that $\overline{AS}$ might not negate between back-to-back Port X transactions if ASFALL is set to 0x0 and ASRISE is set to the maximum allowed value.

Figure 6-47 shows the timing for a Port X read access.



Note: The data must be valid by end of the duration of ROMFAL + 2 clocks. The timing of data valid relative to the assertion of RCS*n* is dependent on the target device.

Figure 6-47. Port X Read Access Timing

Figure 6-48 shows the timing for a Port X write access.

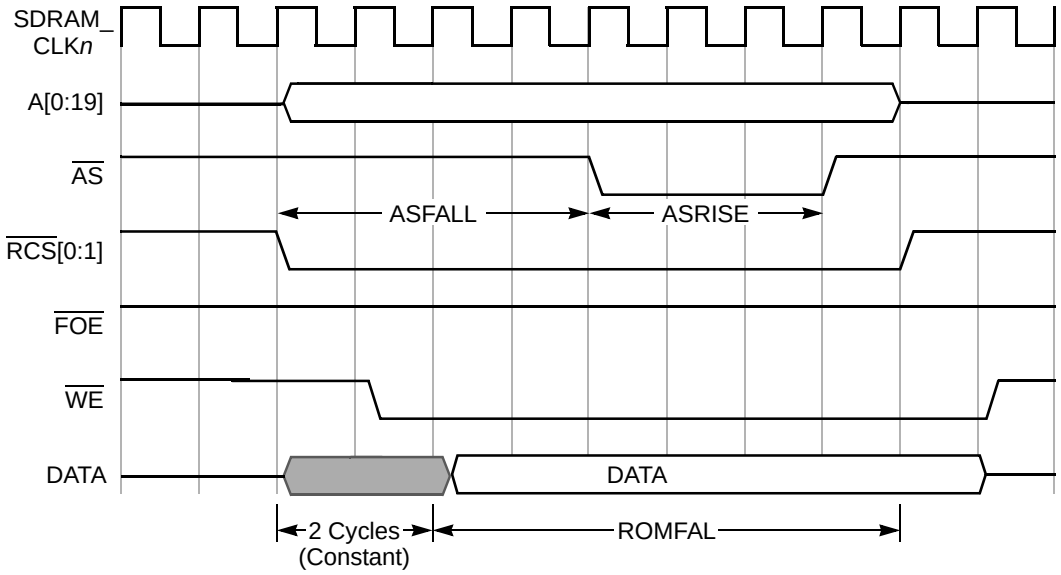


Figure 6-48. Port X Write Access Timing

The minimum negation times between Port X transactions are given in the appropriate TS_WAIT_TIMER description in Table 4-40, Table 4-41, or Table 4-50. Note that these times are typically greater due to processor and CCU activity.

6.3.5.3 Port X Strobe Mode

Port X strobe mode allows communication with a device that has relatively fast known or predictable performance. It is an option for the extended ROM interface ($\overline{RCS2}$ and $\overline{RCS3}$); it is not supported in the base ROM space ($\overline{RCS0}$ and $\overline{RCS1}$). Port X strobe mode is enabled by programming RCSn_CTL = 0b10.

In Port X strobe mode, the assertion time for $\overline{RCSn}$ and $\overline{AS}$ can be terminated prematurely by the assertion of the $\overline{DRDY}$ signal. Unless interrupted by $\overline{DRDY}$, the timing for Port X strobe mode reads is identical to that described in Section 6.3.5.2, “Port X Timing.”

When an extended ROM bank is in Port X strobe mode, the flash write recovery time (ROMNAL) is disabled.

6.3.5.4 Port X Handshake Mode

Port X handshake mode allows communication with a device that has very slow, unknown, or unpredictable performance. It is an option for the extended ROM interface ($\overline{RCS2}$ and $\overline{RCS3}$); it is not supported in the base ROM space ($\overline{RCS0}$ and $\overline{RCS1}$). Port X handshake mode is enabled by programming RCSn_CTL = 0b11.

In Port X handshake mode, the chip-select active timing is controlled by the receipt of the $\overline{DRDY}$ signal. Both $\overline{RCSn}$ and $\overline{AS}$ are held asserted until the $\overline{DRDY}$ signal is asserted by the external device. The assertion of $\overline{DRDY}$ by the Port X device indicates that the requested transaction has been completed.

Figure 6-49 shows the timing for a Port X read access.

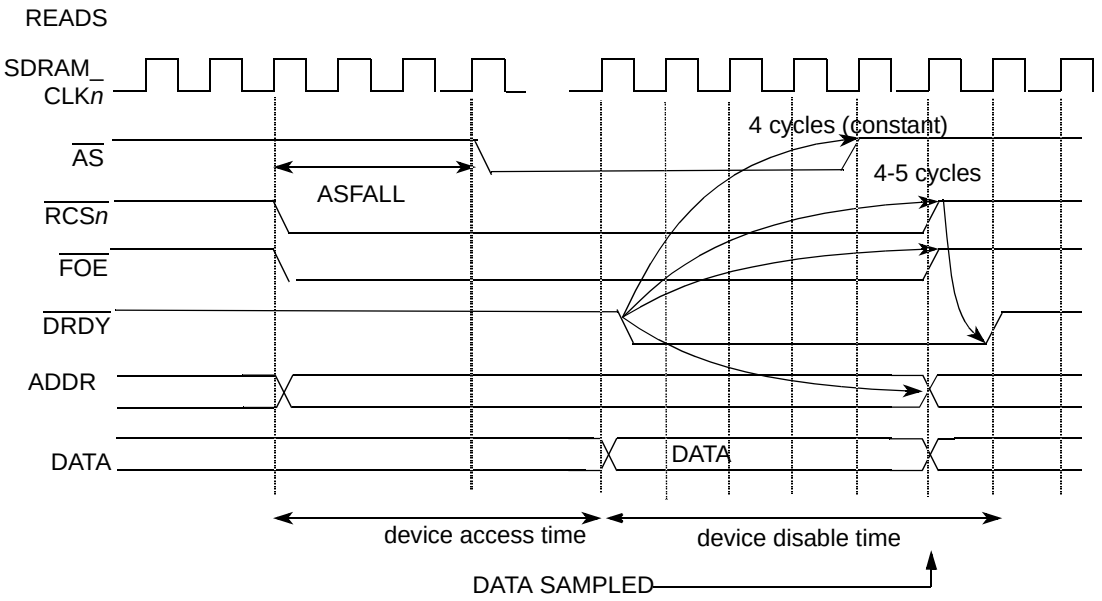


Figure 6-49. Port X Handshake Mode Read Timing

Figure 6-50 shows the timing for a Port X handshake mode write access.

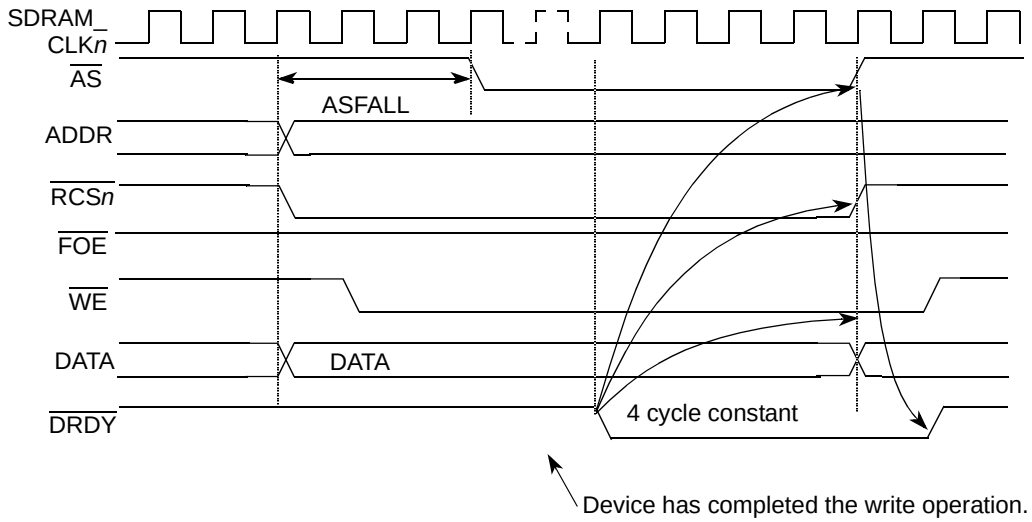


Figure 6-50. Port X Handshake Mode Write Timing

ASFALL is the only relevant timing parameter in Port X handshake mode; the ASRISE and ROMFAL parameters are ignored. In addition, when an extended ROM bank is set for Port X handshake mode, the flash write recovery time (ROMNAL) is disabled for that chip select.

In handshake mode, the Port X controller prevents any other activity in the memory system from starting until the $\overline{\text{DRDY}}$ has been negated. While the memory controller waits for $\overline{\text{DRDY}}$ to be asserted by external logic, all other memory transactions that require the address bus are effectively stalled. For SDRAM systems with paging enabled, this includes row precharges and CBR refreshes. If $\overline{\text{DRDY}}$ is never asserted or is held inactive for a period of time greater than the SDRAM refresh interval, memory may degrade and the memory controller will hang.

It is the responsibility of system hardware to insure that $\overline{\text{DRDY}}$ is asserted for every assertion of $\overline{\text{RCS}n}$ in handshake mode and that $\overline{\text{DRDY}}$ is held active until $\overline{\text{RCS}n}$ is negated. Furthermore, it is up to firmware to insure that the worst-case $\overline{\text{DRDY}}$ timing is taken into account when programming the SDRAM refresh interval (MCCR2[REFINT]).

6.3.6 PCI-to-ROM/Port X Transaction Example

The figures in this section provide examples of signal timing for PCI-to-ROM/Port X transactions. Figure 6-51 shows a series of PCI reads from ROM/Port X(64-Bit).

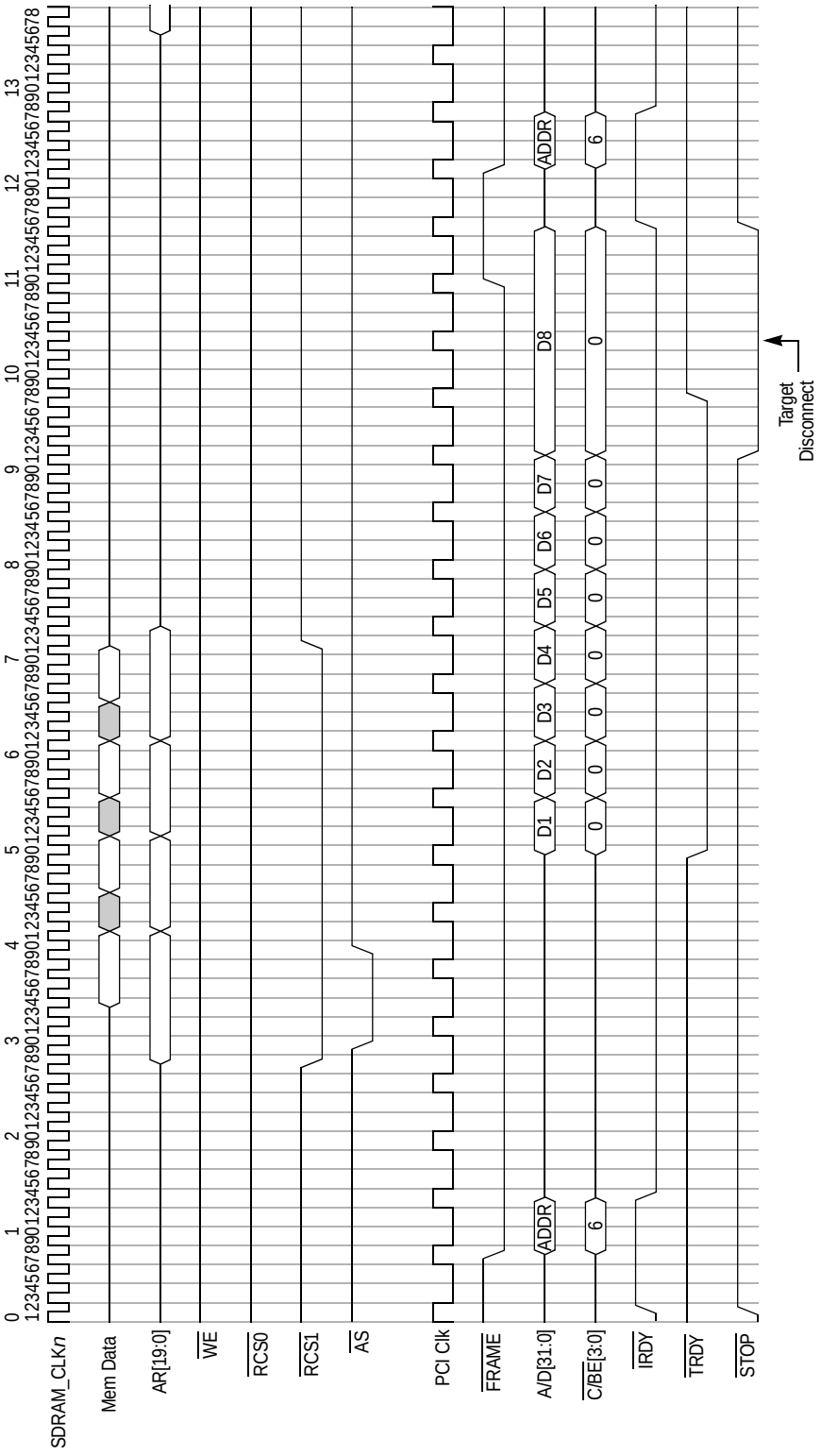


Figure 6-51. PCI Read from ROM/Port X 64-Bit

Figure 6-52 shows a series of PCI reads from ROM/Port X (8-Bit).

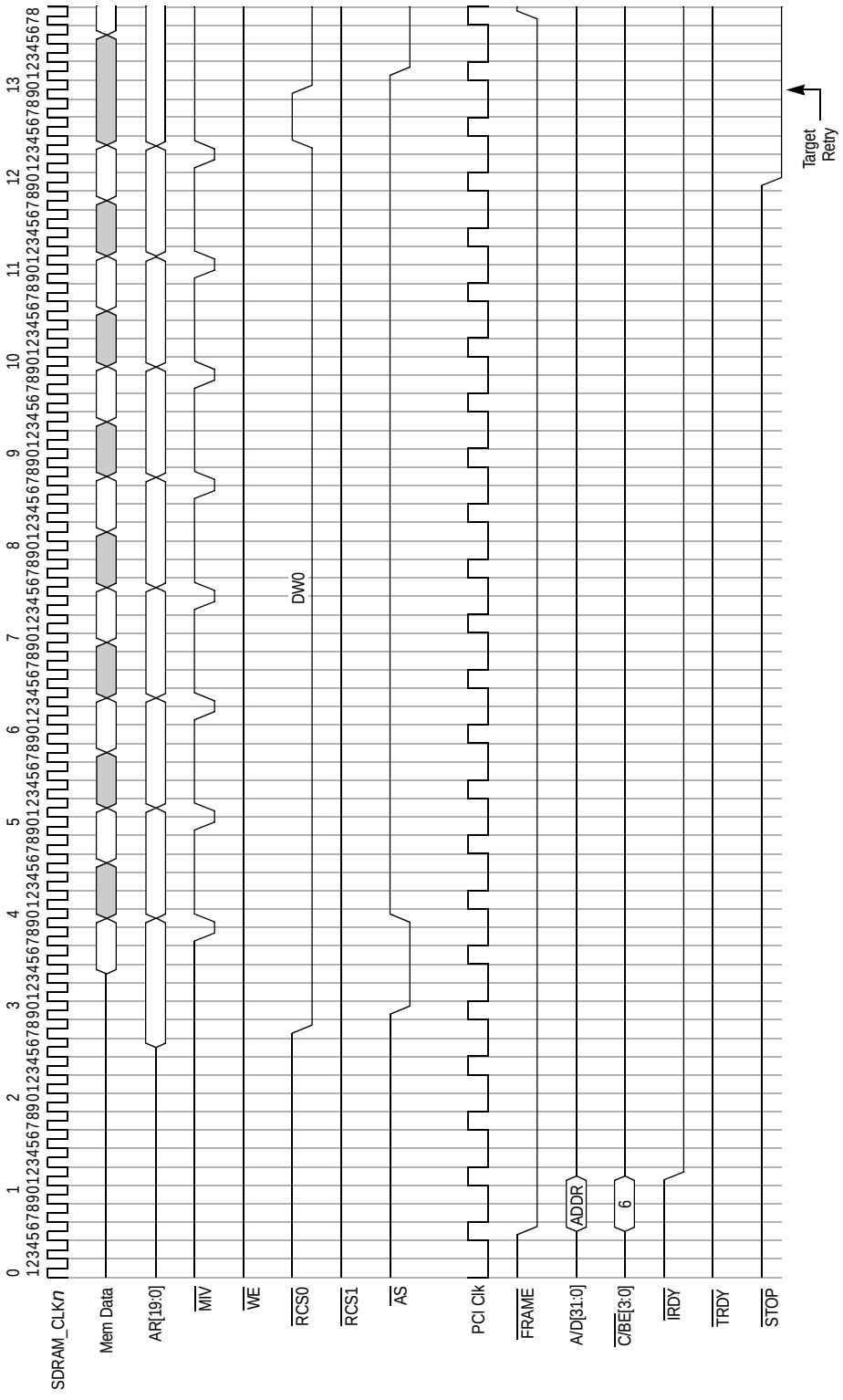


Figure 6-52. PCI Read from ROM/Port X 8-Bit (Part 1 of 4)

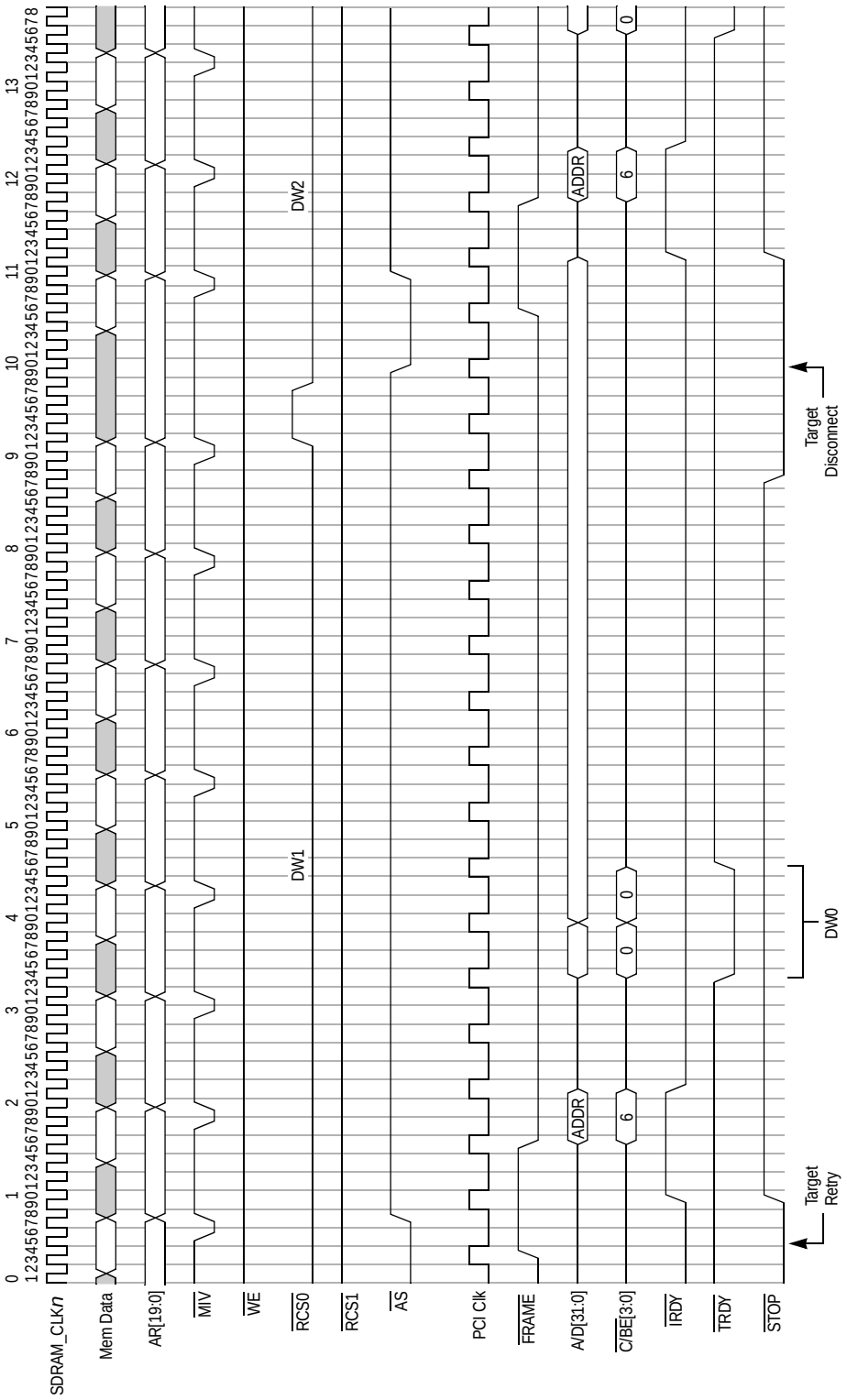


Figure 6-52. PCI Read from ROM/Port X 8-Bit (Part 2 of 4)

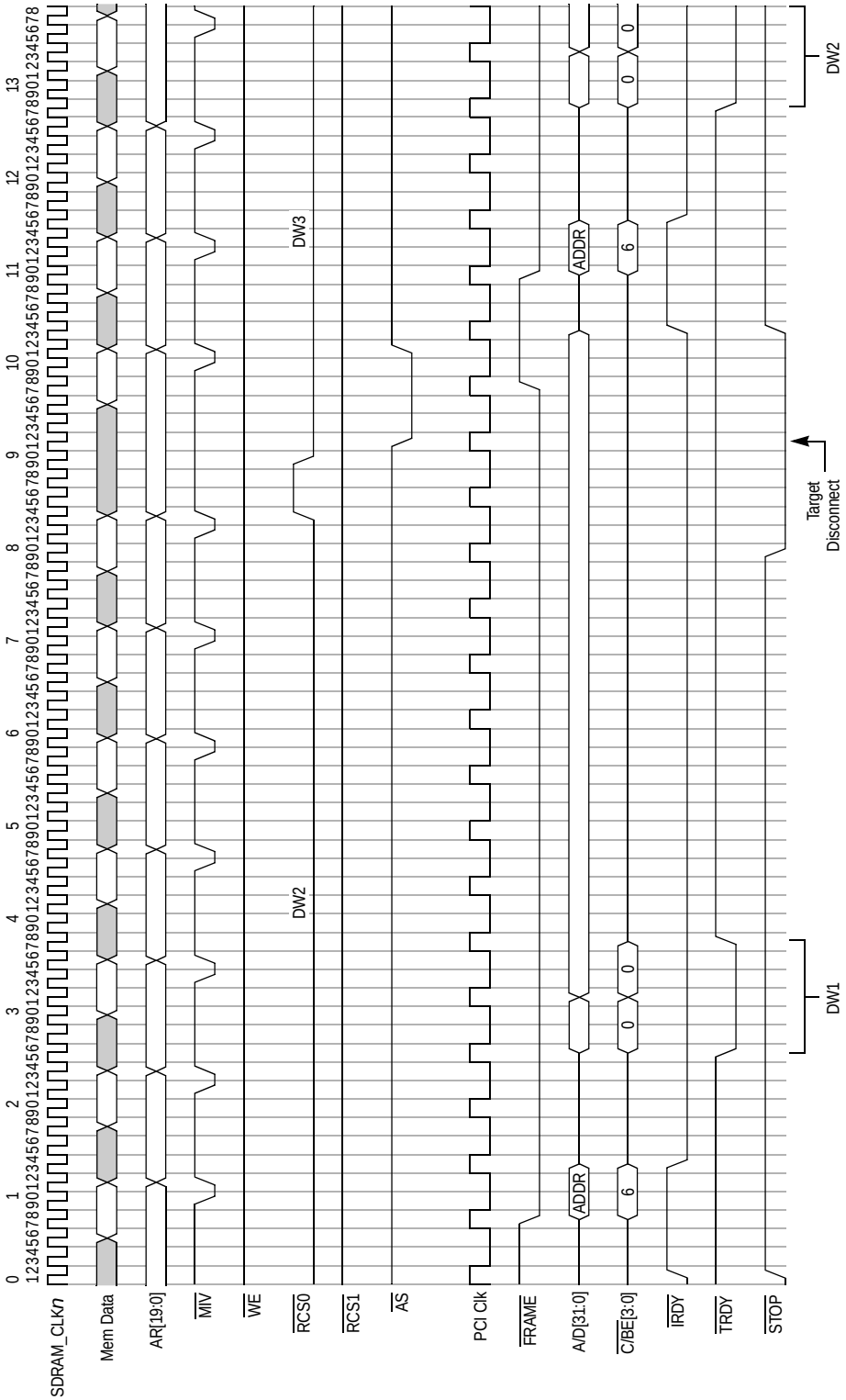


Figure 6-52. PCI Read from ROM/Port X 8-Bit (Part 3 of 4)

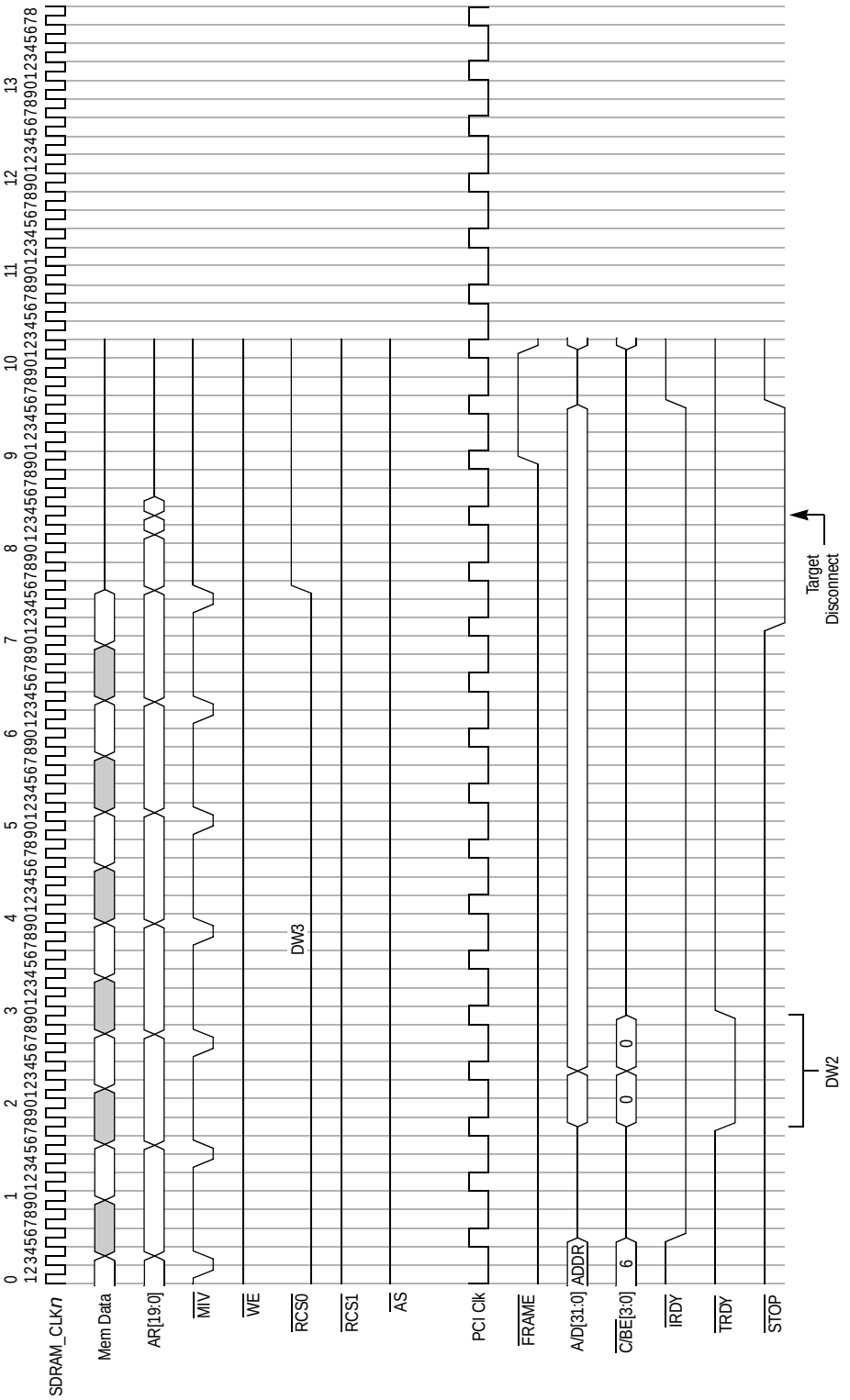


Figure 6-52. PCI Read from ROM/Port X 8-Bit (Part 4 of 4)

Chapter 7
PCI Bus Interface

The MPC8245 PCI interface complies with the *PCI Local Bus Specification*, Rev. 2.2. It is beyond the scope of this manual to document the intricacies of the PCI bus. This chapter provides a basic description of the PCI bus operations. The specific emphasis is directed at MPC8245 implementation of the PCI bus. Designers of systems incorporating PCI devices should refer to the *PCI Local Bus Specification*, Rev. 2.2, for a thorough description of the PCI local bus.

NOTE

Much of the available PCI literature refers to a 16-bit quantity as a word and a 32-bit quantity as a double word. Because this usage is inconsistent with the terminology in this manual, the terms ‘word’ and ‘double word’ are not used in this chapter. Instead, the number of bits or bytes indicates the exact quantity.

7.1 PCI Interface Overview

The PCI interface connects the processor core and local memory to the PCI bus, to which I/O components are connected. The PCI bus uses a 32-bit multiplexed address/data bus plus various control and error signals. The PCI interface supports address and data parity with error checking and reporting. Internal buffers are provided for operations between the PCI bus and the processor core or local memory. Processor read and write operations each have a 32-byte buffer, and memory operations have two 32-byte read buffers and two 32-byte write buffers. Additionally, PCI accesses to local memory must share access to the processor/memory data bus with other MPC8245 resources (for example, the DMA controller). See Chapter 13, “Central Control Unit,” for more information about both the internal read and write buffers and the arbitration priorities for the shared processor/memory data bus.

The PCI interface of the MPC8245 functions both as a master (initiator) and a target device. Two state machines (one for master and one for target operation) run independently of each other and control the PCI interface of the MPC8245, allowing the MPC8245 to handle two separate PCI transactions simultaneously. For example, if the MPC8245, as an initiator, is trying to run a burst-write to a PCI device, it might be disconnected before finishing the transaction. If another PCI device is granted the PCI bus and requests a burst-read from

local memory, the MPC8245, as a target, can accept the burst-read transfer. When the MPC8245 is granted mastership of the PCI bus, the burst-write transaction continues.

As an initiator, the MPC8245 supports read and write operations to the PCI memory space, the PCI I/O space, and the 256-byte PCI configuration space. As an initiator, the MPC8245 also supports generating PCI special-cycle and interrupt-acknowledge transactions. As a target, the MPC8245 supports read and write operations to local memory, and read and write operations to the internal PCI-accessible configuration registers.

The MPC8245 can function as either a PCI host bridge called *host mode* or a peripheral device on the PCI bus called *agent mode*.

NOTE

Agent mode is supported only for address map B. See Section 7.7, “PCI Host and Agent Modes,” for more information.

All of the PCI-accessible configuration registers in the MPC8245 can be programmed from the PCI bus. However, the PICRs, MICRs, and other configuration registers are not accessible from the PCI bus, and the processor core must program them. See Section 7.7.2, “Accessing the MPC8245 Configuration Space,” for more information.

The PCI interface provides bus arbitration for the MPC8245 and up to five other PCI bus masters. The arbitration algorithm is a programmable two-level round-robin priority selector. The on-chip PCI arbiter can operate in both host and agent modes. or it can be disabled to allow for an external PCI arbiter.

The MPC8245 also provides an address translation mechanism to map inbound PCI to local memory accesses and outbound processor core to PCI accesses. Address translation is required when the MPC8245 is operating in agent mode. Address translation is not supported in host mode. See Section 7.7.4, “PCI Address Translation Support,” for more information.

The interface can be programmed for either little-endian or big-endian formatted data, and provides data swapping, byte enable swapping, and address translation in hardware. See Appendix A, “Bit and Byte Ordering,” for more information about the bi-endian features of the MPC8245.

7.1.1 MPC8245 as a PCI Initiator

Upon detecting a processor-to-PCI transaction, the MPC8245 requests use of the PCI bus. For processor-to-PCI bus write operations, the MPC8245 requests mastership of the PCI bus when the processor completes the write operation on the internal peripheral logic bus. For processor-to-PCI read operations, the MPC8245 requests mastership of the PCI bus when it decodes that the access is for PCI address space.

When granted, the MPC8245 drives the 32-bit PCI address (AD[31:0]) and the bus command ($\overline{\text{C/BE}}$[3:0]) signals. The master interface supports reads and writes of up to 32 bytes without inserting master-initiated wait states.

The master part of the interface can initiate master-abort cycles, recognizes target-abort, target-retry, and target-disconnect cycles, and supports various device selection timings. The master interface does not run fast back-to-back or exclusive accesses.

7.1.2 MPC8245 as a PCI Target

As a target, on detection of a PCI address phase, the MPC8245 decodes the address and bus command to determine if the transaction is for local memory. If the transaction is destined for local memory, the target interface latches the address, decodes the PCI bus command, and forwards them to an internal control unit. On writes to local memory, data is forwarded with the byte enables to the internal control unit. On reads, 4 bytes of data are provided to the PCI bus and the byte enables determine which byte lanes contain meaningful data.

The target interface of the MPC8245 can issue target-abort, target-retry, and target-disconnect cycles. The target interface supports fast back-to-back transactions and exclusive accesses using the PCI lock protocol. The target interface uses the fastest device selection timing.

MPC8245 supports data streaming to and from local memory and can accept or provide data to or from local memory if the internal PCI-to-system-memory-write-buffers (PCMWBs) or PCI-to-system-memory-read buffers (PCMRBs) are not filled. For more information about the MPC8245 internal buffers, see Chapter 13, “Central Control Unit.”

The two 32-byte PCMWBs include one filled from the PCI master and the other flushed to local memory. Some memory operations (such as refresh) can stall the flushing of the PCMWBs. In that case, the MPC8245 issues a target disconnect when no space remains in the PCMWBs. Any transactions that have a higher priority for use of the data bush stall the flushing of the PCMWBs (see Section 13.2.2, “Internal Arbitration Priorities”).

Burst reads from local memory are accepted with wait states inserted, depending on the timing of local memory devices. The MPC8245 has two 32-byte PCMRBs and can provide continuous data to a PCI master by flushing one PCMRB to the PCI master while the other is filled from local memory.

7.1.3 PCI Signal Output Hold Timing

To meet minimum output hold specifications that are relative to PCI_SYNC_IN for both 33 MHz and 66 MHz PCI systems, the MPC8245 has a programmable output hold delay for PCI signals. Values on the $\overline{\text{MCP}}$ and CKE power-on reset configuration signals determine the initial value of the output hold delay (see Section 2.4, “Configuration Signals Sampled at Reset”). Programming the PCI_HOLD_DEL value of the PMCR2

configuration register makes more output hold delay values available. Refer to Section 4.3.2, “Power Management Configuration Register 2 (PMCR2)—Offset 0x72” and the *MPC8245 Integrated Processor Hardware Specifications* for more information about these values and signal timing.

7.1.4 PCI 2.2-Compatible Extensions to MPC8240 and the Tundra Tsi107™ PowerPC Host Bridge

The following features are added to the MPC8245 (compared to the MPC8240 and the Tundra Semiconductor Corporation (Tundra) Tsi107 PowerPC host bridge) for PCI 2.2-compatible:

- The MPC8245 supports the Subsystem ID (2 bytes at offset 0x2E) and Subsystem Vendor ID (2 bytes at offset 0x2C) registers. Also, the PCI general control register (2 bytes at offset 0x44) is implemented. Refer to Section 4.2.11, “PCI General Control Register (PGCR)—Offset 0x44,” for more information.
- During the MPC8245 initialization phase, which is extended after hard reset negates, all incoming PCI transactions to it are ignored. This initialization phase takes approximately 32 peripheral logic bus clock cycles. Thus, the MPC8245 does not meet the minimum timing requirement for $\overline{\text{RST}}$ negated to first $\overline{\text{FRAME}}$ assertion (T_{rhff}) of 5 PCI clocks. See the *MPC8245 Integrated Processor Hardware Specifications,* for reset timing requirements.
- By default, $\overline{\text{LOCK}}$ is no longer supported when the MPC8245 is configured as an agent. Thus, the MPC8245 does not sample the $\overline{\text{LOCK}}$ signal in agent mode and treats all locked transactions as non-locked transactions. For PCI 2.2 compatible, $\overline{\text{LOCK}}$ should be sampled only when the MPC8245 is in host mode as a target. Note that a bit in the PCI general control register controls the support of $\overline{\text{LOCK}}$, and this bit can be programmed to overwrite this default functionality. Refer to Section 4.2.11, “PCI General Control Register (PGCR)—Offset 0x44,” for more information.

7.2 PCI Bus Arbitration

PCI bus arbitration is access-based. Bus masters must arbitrate for each access performed on the bus. The PCI bus uses a central arbitration scheme where each master has its own unique request ($\overline{\text{REQ}}$) output and grant ($\overline{\text{GNT}}$) input signal. A simple request/grant handshake is used to gain access to the bus. Arbitration for the bus occurs during the previous access so that no PCI bus cycles are consumed due to arbitration (except when the bus is idle).

The MPC8245 provides bus arbitration logic for it and up to five other PCI bus masters. The on-chip PCI arbiter is independent of host or agent mode. The on-chip PCI arbiter functions in both host and agent modes, or it can be disabled to allow for an external PCI arbiter.

A configuration signal (MAA2) sampled at the negation of the reset signal ($\overline{\text{HRST_CTRL}}$) determines if the on-chip PCI arbiter is enabled (low) or disabled (high). Programming bit 15 of the PCI arbitration control register (PACR) can also enable or disable the on-chip PCI arbiter. Note that the sense of bit 15 corresponds to the inverse of the polarity of the configuration signal (that is, when bit 15 = 1 the arbiter is enabled, and when bit 15 = 0 the arbiter is disabled). See Section 2.4, “Configuration Signals Sampled at Reset,” for more information about the reset configuration signals.

If the on-chip PCI arbiter is enabled, a request-grant pair of signals is provided for each external master ($\overline{\text{REQ}}$[0:4] and $\overline{\text{GNT}}$[0:4]). Furthermore, an internal request/grant pair for the internal master state machine of the MPC8245 governs processor accesses to the PCI and PCI transactions that the DMA controller (functioning as a PCI agent) initiates. If the on-chip PCI arbiter is disabled, the MPC8245 uses the $\overline{\text{GNT0}}$ signal as an output to issue its request to the external arbiter and uses the $\overline{\text{REQ0}}$ signal as an input to receive its grant from the external arbiter.

7.2.1 Internal Arbitration for PCI Bus Access

The internal state machine that arbitrates between the two on-chip DMA channels and processor accesses to the PCI bus is separate from the on-chip PCI bus arbiter that controls the arbitration between the MPC8245 and external PCI bus masters (enabled by the PCI arbiter control register at offset 0x46). This internal arbiter for MPC8245 resources is always enabled, and its output is the combined internal request/grant pair for the MPC8245. The order of progression of priorities between these accesses is shown in Figure 7-1.

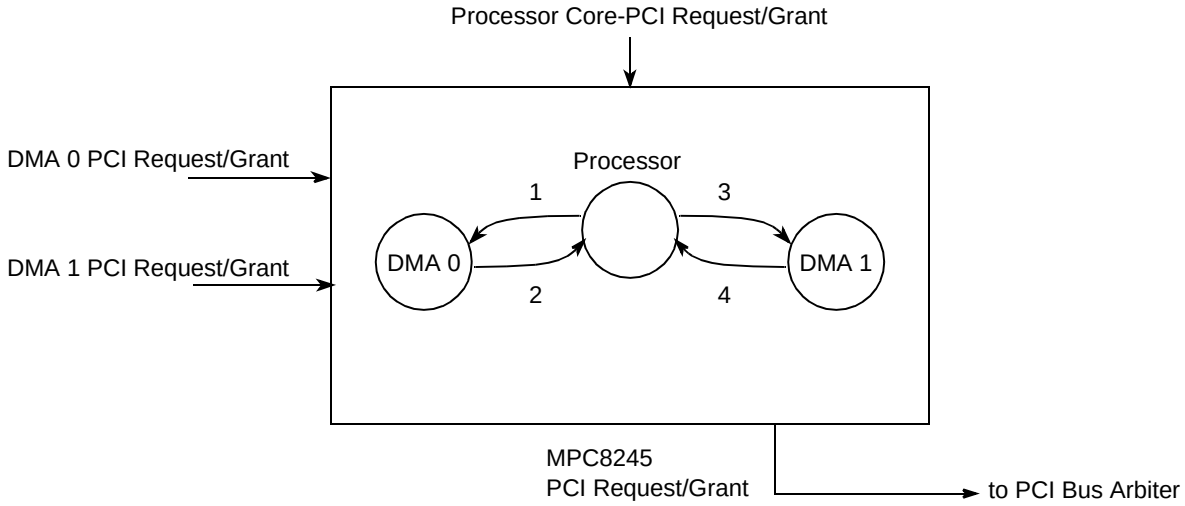


Figure 7-1. Internal Processor DMA Arbitration for PCI Bus

As shown in Figure 7-1, the priorities propagate as follows: processor-DMA channel 0-processor-DMA channel 1-processor-DMA channel 0, and so on. Processor and DMA transactions allow for rearbitration (arbiter state transitions) at PCI transaction boundaries.

7.2.1.1 Processor-Initiated Transactions to PCI Bus

The PCI transaction boundaries for processor-initiated transactions occur at the successful completion of each processor transaction. Loss of mastership on the PCI bus or PCI latency timer register (PLTR) can cause interruption of processor transactions to the PCI bus before completion (see Section 4.2.6, “Latency Timer—Offset 0x0D.” However, this case does not constitute a PCI transaction boundary, and when the MPC8245 regains mastership of the external PCI bus, the processor transaction in progress continues without rearbitration with the DMA controller.

7.2.1.2 DMA-Initiated Transactions to the PCI Bus

PCI transaction boundaries for DMA-initiated transactions allow for rearbitration (arbiter state transitions) after the transmission of up to 4 Kbytes on the PCI bus. In order for a DMA channel to stream (up to 4 Kbytes) between the local memory and the PCI bus, the local memory interface (and the DMA queues) must also be available to sustain the streaming. See Section 13.2, “Internal Arbitration,” for more information about priorities for access to the local memory interface.

DMA streams (up to 4 Kbytes) from local memory to the PCI bus can cause both the local memory and PCI interface to transfer up to 4 Kbytes without interruption. Additionally, DMA transfers from PCI to local memory can cause up to 4 Kbytes to be read from the PCI bus without interruption by the MPC8245. Note, however, that DMA writes (in this case, from PCI) to local memory occur in increments of single cache lines at a time.

Note that the latency timer parameter in the PLTR can affect the streaming of data to the PCI bus. If the latency timer is set to be a shorter period than the time required to transfer 4 Kbytes, the PCI stream breaks when another PCI master is granted mastership of the PCI bus. The latency timer parameter in the PLTR is described further in Section 4.2.6, “Latency Timer—Offset 0x0D.”

As with processor-initiated transactions, DMA-initiated transactions to the PCI bus may be interrupted before completion by the loss of mastership on the PCI bus or by the PCI latency timer. This case does not constitute a PCI transaction boundary, and when the MPC8245 regains mastership of the external PCI bus, the DMA stream in progress continues without rearbitration with the processor.

7.2.2 PCI Bus Arbiter Operation

The following sections describe the operation of the on-chip PCI arbiter that arbitrates between external PCI masters and the internal PCI bus master of the MPC8245.

The on-chip PCI arbiter uses a programmable two-level, round-robin arbitration algorithm. Each of the five external masters, plus the MPC8245, can be programmed for two priority levels, high or low, using the appropriate bits in the PACR. Within each priority group, the

PCI bus grant is asserted to the next requesting device in numerical order, with the MPC8245 positioned before device 0.

Conceptually, the lowest priority device is the master that is currently using the bus, and the highest priority device follows the current master in numerical order and group priority. This algorithm is considered to be fair, because a single device cannot prevent other devices from having access to the bus. The device automatically becomes the lowest priority when it begins to use the bus. If a master is not requesting the bus, its transaction slot is given to the next requesting device within its priority group.

A grant is awarded to the requesting device with highest priority as soon as the current master begins a transaction; however, the granted device must wait until the current master relinquishes the bus before initiating a transaction.

The grant given to a particular device may be removed and awarded to another higher priority device whenever the higher priority device asserts its request. If the bus is idle when a device requests the bus, the arbiter withholds the grant for one clock cycle. The arbiter re-evaluates the priorities of all requesting devices and grants the bus to the highest priority device in the following clock cycle, allowing a turnaround clock when a higher priority device is using address stepping or when the bus is parked.

The low-priority group collectively has one bus transaction request slot in the high-priority group. Mathematically, if there are N high-priority devices and M low-priority devices, each high-priority device is guaranteed to get at least 1 of N+1 bus transactions, and each low-priority device is guaranteed to get at least 1 of $(N+1) \times M$ bus transactions, with one of the low-priority devices receiving the grant in 1 of N+1 bus transactions. If all devices are programmed to the same priority level, or if there is only one device in the low-priority group, the arbitration algorithm defaults to each device receiving an equal number of bus grants, in round-robin sequence.

Figure 7-2 shows an example of the arbitration algorithm. Assume that several masters are requesting use of the bus. If two masters are in the high-priority group and three in the low-priority group, each high-priority master is guaranteed at least one out of three transaction slots, and each low-priority master is guaranteed one out of nine transaction slots.

In Figure 7-2, the grant sequence (with all devices, except device 4 requesting the bus and device 3 being the current master) is 0, 2, MPC8245, 0, 2, 1, 0, 2, 3, …, and repeating. If device 2 is not requesting the bus, the grant sequence is 0, MPC8245, 0, 1, 0, 3, …, and repeating. If device 2 requests the bus when device 0 is conducting a transaction and the MPC8245 has the next grant, the MPC8245 grant is removed and device 2 is awarded the grant because device 2 is higher priority than the MPC8245 when device 0 has the bus.

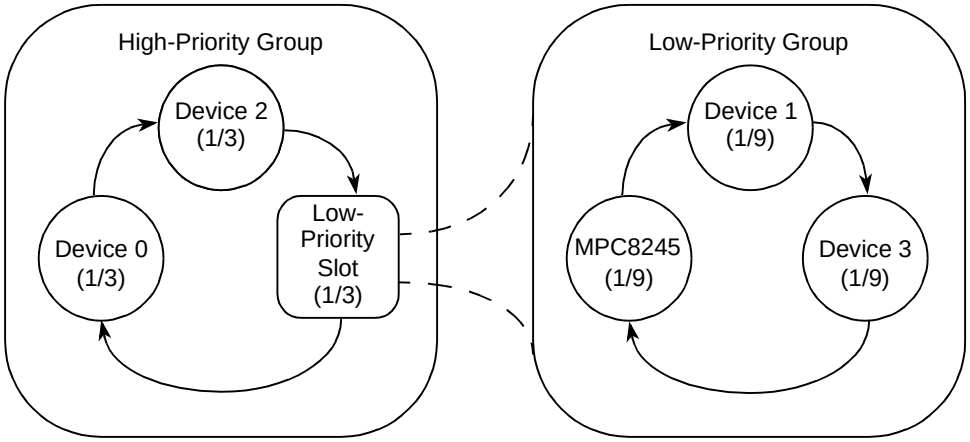


Figure 7-2. PCI Arbitration Example

7.2.3 PCI Bus Parking

When no device is using or requesting the bus, the PCI arbiter grants the bus to a selected device, *parking* the bus on the selected device. The selected device must drive the AD[31:0], $\overline{\text{C/BE}}$[0:3], and PAR signals to a stable value, preventing these signals from floating.

The parking mode control parameter (bits 14–13) in the PACR determines the device that the arbiter selects for parking the PCI bus, as Table 7-1 shows. If the parking mode control bits are 0b00 (or if the bus is not idle), the bus is parked on the last master to use the bus. If the bus is idle and the parking mode control bits are b10, the bus is parked on the MPC8245. If the control bits are b01, the bus is parked on device 0 (that is, the device connected to $\overline{\text{GNT0}}$).

Table 7-1. PCI Arbiter Control Register Parking Mode Bits

PCI Arbiter Control Register [14–13]	Parking Mode
00	Parked on last master
01	Parked on the device using $\overline{\text{REQ0}}$ and $\overline{\text{GNT0}}$
10	Parked on MPC8245
11	Reserved

7.2.4 Power-Saving Modes and the PCI Arbiter

In the sleep power-saving mode, the clock signal driving PCI_SYNC_IN can be disabled. If the clock is disabled, the arbitration logic is not able to perform its function. System programmers must park the bus with a device that can sustain the AD[31:0], $\overline{\text{C/BE}}$[3:0], and PAR signals before disabling the PCI_SYNC_IN signal. If the bus is parked on the MPC8245 when its clocks are stopped, the MPC8245 sustains the AD[31:0], $\overline{\text{C/BE}}$[3:0],

and PAR signals in their prior states. In this situation, the only way for another agent to use the PCI bus is to wake the MPC8245. In nap and doze power-saving modes, the arbiter continues to operate, allowing other PCI devices to run transactions.

7.2.5 Broken Master Lock-Out

The PCI bus arbiter on the MPC8245 has a feature that allows it to lock out any masters that are broken or ill-behaved. Programming bit 12 of the PCI arbitration control register (0b0 = enabled, 0b1 = disabled controls the broken master feature.

When the broken master feature is enabled, a granted device that does not assert $\overline{\text{FRAME}}$ within 16 PCI clock cycles after the bus is idle loses its grant. Subsequently, requests are ignored until its $\overline{\text{REQ}}$ is negated for at least one clock cycle. This factor prevents ill-behaved masters from monopolizing the bus. When the broken master feature is disabled, a device that requests the bus and receives a grant never loses its grant until and unless it begins a transaction or negates its $\overline{\text{REQ}}$ signal.

NOTE

Motorola does not recommend disabling the broken master feature.

7.3 MPC8245 PCI Bus Protocol

This section provides a general description of the PCI bus protocol. Specific PCI bus transactions are described in Section 7.4, “PCI Bus Transactions.” Refer to Figure 7-3, Figure 7-4, Figure 7-5, and Figure 7-6 for examples of the transfer-control mechanisms that are described in this section.

All signals are sampled on the rising edge of the PCI bus clock (PCI_SYNC_IN). Each signal has a setup and hold aperture with respect to the rising clock edge in which transitions are not allowed. Outside this aperture, signal values or transitions have no significance. See the *MPC8245 Integrated Processor Hardware Specifications* for specific setup and hold times.

7.3.1 Basic Transfer Control

The basic PCI bus transfer mechanism is a *burst*, which is composed of an address phase followed by one or more data phases. Fundamentally, three signals—$\overline{\text{FRAME}}$ (frame), $\overline{\text{IRDY}}$ (initiator ready), and $\overline{\text{TRDY}}$ (target ready) control all PCI data transfers. An initiator asserts $\overline{\text{FRAME}}$ to indicate the beginning of a PCI bus transaction and negates $\overline{\text{FRAME}}$ to indicate the end of a PCI bus transaction. An initiator negates $\overline{\text{IRDY}}$ to force wait cycles. A target negates $\overline{\text{TRDY}}$ to force wait cycles.

The PCI bus is considered idle when both $\overline{\text{FRAME}}$ and $\overline{\text{IRDY}}$ are negated. The first clock cycle in which $\overline{\text{FRAME}}$ is asserted indicates the beginning of the address phase. The

address and bus command code are transferred in that first cycle. The next cycle begins the first of one or more data phases. Data is transferred between initiator and target in each cycle that both IRDY and TRDY are asserted. Using either the initiator (by negating IRDY) or the target (by negating TRDY) can insert wait cycles in a data phase.

When an initiator has asserted IRDY, it cannot change IRDY or FRAME until the current data phase completes, regardless of the state of TRDY. When a target has asserted TRDY or STOP, it cannot change DEVSEL, TRDY, or STOP until the current data phase completes. In simpler terms, when an initiator or target commits to the data transfer, it cannot retract the commitment.

When the initiator intends to complete only one more data transfer (which could be immediately after the address phase), FRAME is negated and IRDY is asserted (or kept asserted), indicating the initiator is ready. After the target indicates the final data transfer (by asserting TRDY), the PCI bus may return to the idle state in which both FRAME and IRDY are negated unless a fast back-to-back transaction is in progress. In the case of a fast back-to-back transaction, an address phase immediately follows the last data phase.

7.3.2 PCI Bus Commands

A PCI bus command is encoded in the C/BE[3:0] signals during the address phase of a PCI transaction. The bus command indicates to the target the type of transaction the initiator is requesting. Table 7-2 describes the PCI bus commands that the MPC8245 implements.

Table 7-2. PCI Bus Commands

C/BE[3:0]	PCI Bus Command	MPC8245 Supports as an Initiator	MPC8245 Supports as a Target	Definition
0000	Interrupt-acknowledge	Yes	No	The interrupt-acknowledge command is a read (implicitly addressing the system interrupt controller). Only one device on the PCI bus should respond to the interrupt-acknowledge command. Other devices ignore the interrupt-acknowledge command. See Section 7.4.7.1, “Interrupt-Acknowledge Transactions,” for more information.
0001	Special cycle	Yes	No	The special-cycle command provides a mechanism to broadcast select messages to all devices on the PCI bus. See Section 7.4.7.2, “Special-Cycle Transactions,” for more information.
0010	I/O-read	Yes	No	The I/O-read command accesses agents mapped into the PCI I/O space.
0011	I/O-write	Yes	No	The I/O-write command accesses agents mapped into the PCI I/O space.
0100	Reserved [1]	No	No	—
0101	Reserved[1]	No	No	—

Table 7-2. PCI Bus Commands (continued)

$\overline{\text{C/BE}}$[3:0]	PCI Bus Command	MPC8245 Supports as an Initiator	MPC8245 Supports as a Target	Definition
0110	Memory-read	Yes	Yes	The memory-read command accesses either local memory or agents mapped into PCI memory space, depending on the address. When a PCI master issues a memory-read command to local memory, the MPC8245 (the target) fetches data from the requested address to the end of the cache line (32 bytes) from local memory, even though all of the data may not be requested by (or sent to) the initiator.
0111	Memory-write	Yes	Yes	The memory-write command accesses either local memory or agents mapped into PCI memory space, depending on the address.
1000	Reserved[1]	No	No	—
1001	Reserved[1]	No	No	—
1010	Configuration-read	Yes	Yes	The configuration-read command accesses the 256-byte configuration space of a PCI agent. A specific agent is selected when its IDSEL signal is asserted during the address phase. See Section 7.4.6, “Configuration Cycles,” for more detail on PCI configuration cycles.
1011	Configuration-write	Yes	Yes	The configuration-write command accesses the 256-byte configuration space of a PCI agent. A specific agent is selected when its IDSEL signal is asserted during the address phase. See Section 7.4.6.2, “Accessing the PCI Configuration Space,” for more detail on PCI configuration accesses.
1100	Memory-read-multiple	Yes (for DMA cycles)	Yes	The memory-read-multiple command functions similarly to the memory-read command, but it also causes a prefetch of the next cache line (32 bytes). Note that for PCI reads from local memory, prefetching for all reads may be forced by setting bit 2 (PCI speculative read enable) of PICR1. See Section 13.1.3.1.2, “Speculative PCI Reads from Local Memory,” for more information.
1101	Dual-address-cycle	Yes	No	The dual-address-cycle command is used to transfer a 64-bit address (in two 32-bit address cycles) to 64-bit addressable devices.
1110	Memory-read-line	Yes	Yes	The memory-read-line command indicates that an initiator is requesting the transfer of an entire cache line (32 bytes). This only occurs when the processor is performing a burst read. Note that these processors only perform burst reads when the appropriate cache is enabled and the transaction is not cache-inhibited.
1111	Memory-write-and-invalidate	Yes (for DMA cycles)	Yes	The memory-write-and-invalidate command indicates that an initiator is transferring an entire cache line (32 bytes); if this data is in any cacheable memory, that cache line needs to be invalidated.

[1] Reserved command encodings are reserved for future use. The MPC8245 does not respond to these commands.

7.3.3 Addressing

PCI defines the following three physical address spaces:

- PCI memory space
- PCI I/O space
- PCI configuration space

Access to the PCI memory and I/O space is straightforward, although one must take into account the MPC8245 address map (map B) in use. The address maps are described in Chapter 3, “Address Maps.” Access to the PCI configuration space is described in Section 7.4.6, “Configuration Cycles.”

Address decoding on the PCI bus is performed by every device for every PCI transaction. Each agent is responsible for decoding its own address. PCI supports two types of address decoding, *positive* decoding and *subtractive* decoding. For positive decoding, each device is looking for accesses in the address range that was assigned to the device. For subtractive decoding, one device on the bus is looking for accesses that no other device claimed. See Section 7.3.4, “Device Selection,” for information about claiming transactions.

The information contained in the two low-order address bits (AD[1:0]) varies by the address space (memory, I/O, or configuration). Regardless of the encoding scheme, the two low-order address bits are always included in parity calculations.

7.3.3.1 Memory Space Addressing

For memory accesses, PCI defines the following two types of burst ordering controlled by the two low-order bits of the address

- linear incrementing (AD[1:0] = 0b00)
- cache wrap mode (AD[1:0] = 0b10) (shown in)

The other two AD[1:0] possibilities (0b01 and 0b11) are reserved. As an initiator, the MPC8245 always encodes AD[1:0] = 0b00 for PCI memory space accesses. As a target, the MPC8245 executes a target disconnect after the first data phase completes if AD[1:0] = 0b01 or AD[1:0] = 0b11 during the address phase of a local memory access. See Section 7.4.3.2, “Target-Initiated Termination,” for more information about target disconnect conditions.

Table 7-3. Supported Combinations of AD[1:0]

AD[1:0]		MPC8245 as Target		MPC8245 as Initiator	
		Read	Write	Read	Write
00	Linear	√	√	√	√
01	Reserved	TD	TD	—	—

Table 7-3. Supported Combinations of AD[1:0] (continued)

AD[1:0]		MPC8245 as Target		MPC8245 as Initiator	
		Read	Write	Read	Write
10	Cache Wrap	√	TD	—	—
11	Reserved	TD	TD	—	—

For linear incrementing mode, the memory address is encoded and decoded using AD[31:2]. Thereafter, the address is incremented by 4 bytes after each data phase completes until the transaction is terminated or completed (a 4-byte data width per data phase is implied). Note that the two low-order bits on the address bus are included in all parity calculations.

For cache wrap mode (AD[1:0] = 0b10) reads, the critical memory address is decoded using AD[31:2]. The address is incremented by 4 bytes after each data phase completes until the end of the cache line is reached. For cache-wrap reads, the address wraps to the beginning of the current cache line and continues incrementing until the entire cache line (32 bytes) is read. The MPC8245 does not support cache-wrap write operations and executes a target disconnect after the first data phase completes for writes with AD[1:0] = 0b10. Note that the two low-order bits on the address bus are included in all parity calculations.

7.3.3.2 I/O Space Addressing

For PCI I/O accesses, all 32 address signals (AD[31:0]) provide a byte address. After a target claims an I/O access, it must determine if the entire access as the byte enable signals indicate can be completed. If all the selected bytes are not in the address range of the target, the entire access cannot complete. In this case, the target does not transfer any data and terminates the transaction with a target-abort error. See Section 7.4.3.2, “Target-Initiated Termination,” for more information.

7.3.3.3 Configuration Space Addressing

PCI supports two types of configuration accesses that use different formats for the AD[31:0] signals during the address phase. The two low-order bits of the address indicate the format for the configuration address phase, which is either type 0 (AD[1:0] = 0b00) or type 1 (AD[1:0] = 0b01). Both address formats identify a specific device and a specific configuration register for that device. See Section 7.4.6, “Configuration Cycles,” for descriptions of the two formats.

7.3.4 Device Selection

The target of the current transaction drives the $\overline{\text{DEVSEL}}$ signal. $\overline{\text{DEVSEL}}$ indicates to the other devices on the PCI bus that the target has decoded the address and claimed the

transaction. DEVSEL may be driven one, two, or three clock cycles (fast, medium, or slow device select timing) following the address phase. Device select timing is encoded into the device's PCI status register. If no agent asserts DEVSEL within three clock cycles of FRAME, the agent that is responsible for subtractive decoding can assert DEVSEL to claim the transaction.

A target must assert DEVSEL (claim the transaction) before or coincident with any other target response (assert TRDY, STOP, or data signals). In all cases except target-abort, when a target asserts DEVSEL, it must not negate DEVSEL until FRAME is negated (with IRDY asserted) and the last data phase has completed. For normal termination, negation of DEVSEL coincides with the negation of TRDY or STOP.

If the first access maps into a target's address range, that target asserts DEVSEL to claim the access. However, if the initiator attempts to continue the burst access across the resource boundary, the target must issue a target disconnect.

The MPC8245 is hardwired for fast device select timing (PCI status register [10–9] = 0b00). Therefore, when the MPC8245 is the target of a transaction (local memory access or configuration register access in agent mode), it asserts DEVSEL one clock cycle after the address phase.

As an initiator, if the MPC8245 does not detect the assertion of DEVSEL within four clock cycles after the address phase (that is, five clock cycles after it asserts FRAME), it terminates the transaction with a master-abort termination (see Section 7.4.3.1, "Master-Initiated Termination").

7.3.5 Byte Alignment

The byte enable signals of the PCI bus (C/BE[3:0], during a data phase) determine which byte lanes carry meaningful data. The byte enable signals may enable different bytes for each of the data phases. The byte enables are valid on the edge of the clock that starts each data phase and stay valid for the entire data phase. Note that parity is calculated for all bytes regardless of the state of the byte enable signals. See Section 7.6.1, "PCI Parity," for more information.

If the MPC8245, as a target, detects no byte enables asserted, it completes the current data phase without permanent change. This factor implies that on a read transaction, the MPC8245 expects that the data is not changed, and on a write transaction, the data is not stored.

7.3.6 Bus Driving and Turnaround

To avoid contention, a *turnaround* cycle is required on all signals that more than one agent may drive. The turnaround cycle occurs at different times for different signals. The IRDY, TRDY, DEVSEL, and STOP signals use the address phase as their turnaround cycle.

FRAME, C/BE[3:0], and AD[31:0] signals use the idle cycle between transactions (when both FRAME and IRDY are negated) as their turnaround cycle. The PERR signal has a turnaround cycle on the fourth clock after the last data phase.

The PCI address/data signals, AD[31:0], are driven to a stable condition during every address/data phase. Even when the byte enables indicate that byte lanes carry meaningless data, the signals carry stable values. Parity is calculated on all bytes regardless of the byte enables. See Section 7.6.1, “PCI Parity,” for more information.

7.4 PCI Bus Transactions

This section provides descriptions of the PCI bus transactions. All bus transactions follow the protocol as described in Section 7.3, “MPC8245 PCI Bus Protocol.” Read and write transactions, which are similar for the memory and I/O spaces, are described as generic read transactions and generic write transactions.

The timing diagrams in this section show the following relationships of significant signals involved in bus transactions:

- When a signal is drawn as a solid line, the current master or target is actively driving it.
- When a signal is drawn as a dashed line, no agent is actively driving it.
- High-impedance signals have indeterminate values when the dashed line is shown between the two rails.

The terms *edge* and *clock edge* always refer to the rising edge of the clock. The terms *asserted* and *negated* always refer to the globally visible state of the signal on the clock edge, rather than to signal transitions. The graphic ‘ ’ represents a turnaround cycle in the timing diagrams.

7.4.1 PCI Read Transactions

This section describes PCI *single-beat* read transactions and PCI *burst* read transactions.

A read transaction starts with the address phase, and occurs when an initiator asserts FRAME. During the address phase, AD[31:0] contains a valid address and C/BE[3:0] contains a valid bus command.

The first data phase of a read transaction requires a turnaround cycle to allow the transition from the initiator driving AD[31:0] as address signals to the target driving AD[31:0] as data signals. The target with the TRDY signal enforces the turnaround cycle. The target provides valid data at the earliest one cycle after the turnaround cycle. The target must drive the AD[31:0] signals when DEVSEL is asserted.

During the data phase, the C/BE[3:0] signals indicate which byte lanes are involved in the current data phase. A data phase may consist of a data transfer and wait cycles. The

C/BE[3:0] signals remain actively driven for both reads and writes from the first clock of the data phase through the end of the transaction.

A data phase completes when data is transferred, which occurs when both IRDY and TRDY are asserted on the same clock edge. When either IRDY or TRDY is negated, a wait cycle is inserted and no data is transferred. The initiator negates FRAME when IRDY is asserted to indicate the last data phase. The transaction is considered complete when data is transferred in the last data phase.

Figure 7-3 illustrates a PCI single-beat read transaction. Figure 7-4 illustrates a PCI burst read transaction.

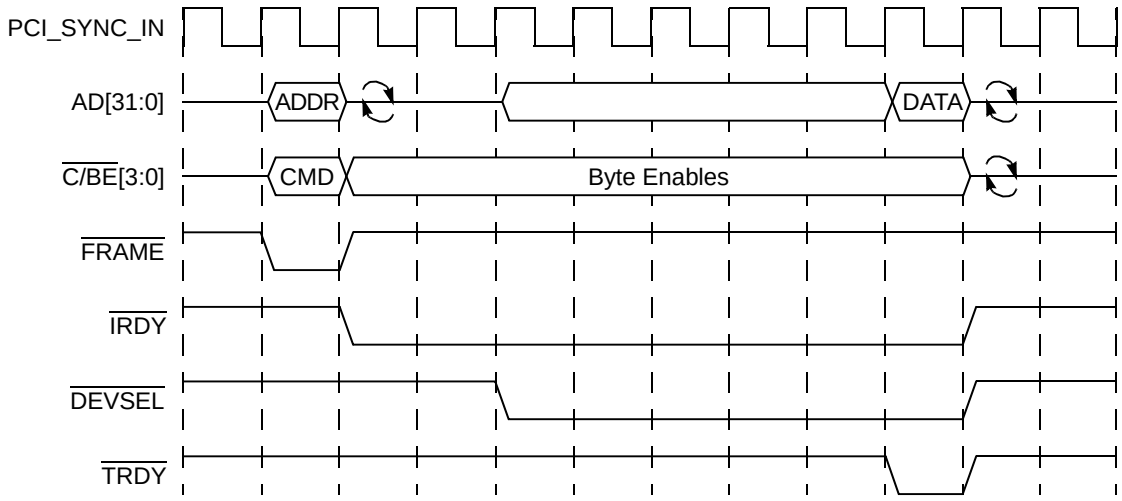


Figure 7-3. PCI Single-Beat Read Transaction

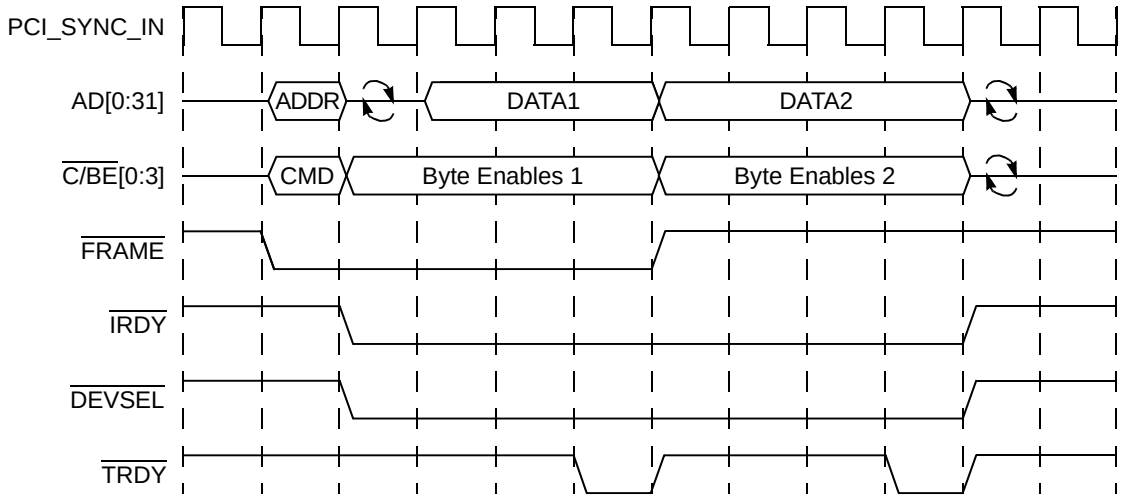


Figure 7-4. PCI Burst Read Transaction

7.4.2 PCI Write Transactions

This section describes PCI single-beat write transactions and PCI burst write transactions. A PCI write transaction starts with the address phase, and occurs when an initiator asserts FRAME. A write transaction is similar to a read transaction, except that no turnaround cycle is needed following the address phase because the initiator provides both address and data. The data phases are the same for both read and write transactions. Although the figures do not show this factor, the initiator must drive the C/BE[3:0] signals, even if the initiator is not ready to provide valid data (IRDY negated).

Figure 7-5 illustrates a PCI single-beat write transaction. Figure 7-6 illustrates a PCI burst write transaction.

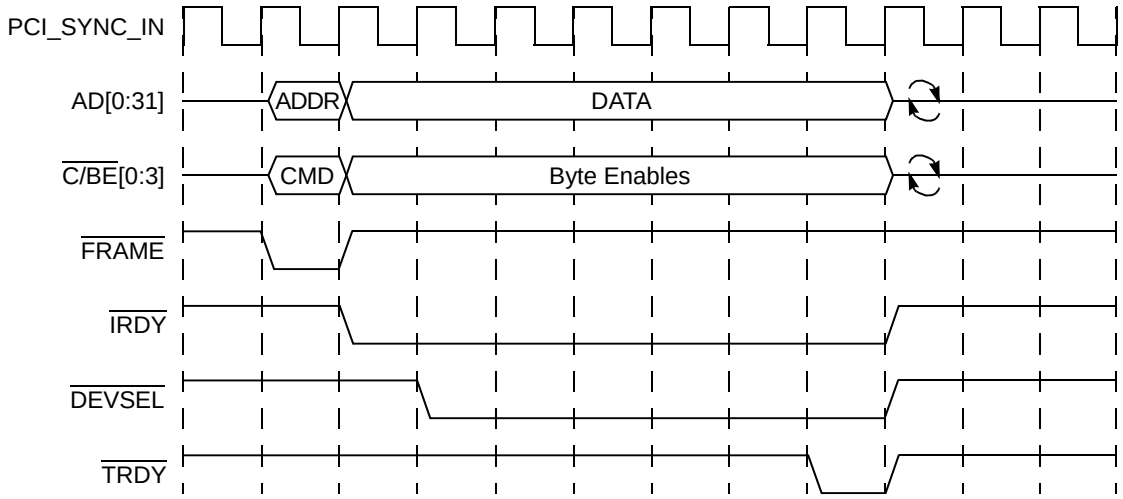


Figure 7-5. PCI Single-Beat Write Transaction

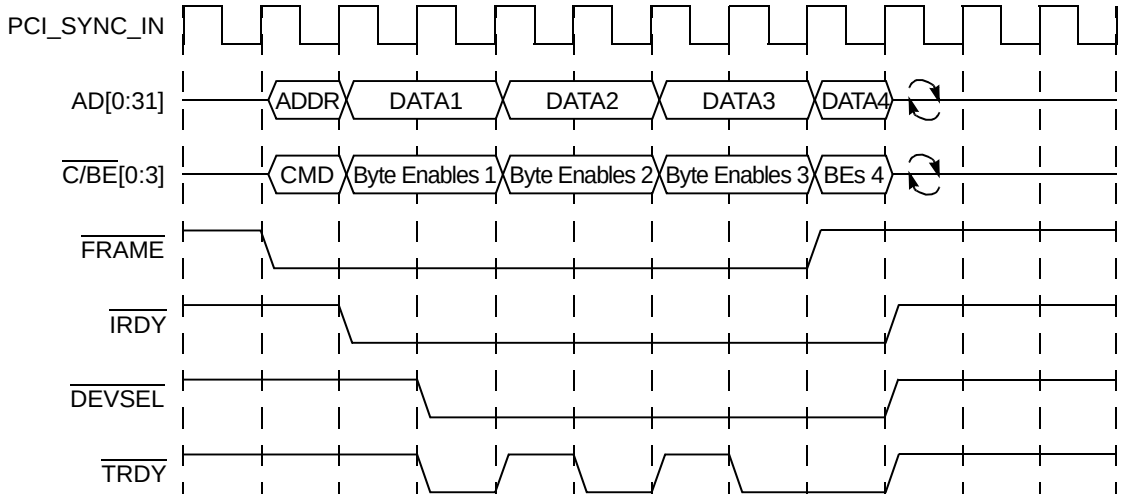


Figure 7-6. PCI Burst Write Transaction

7.4.3 Transaction Termination

Either the initiator or the target may terminate a PCI transaction. The initiator is ultimately responsible for concluding all transactions, regardless of the terminating cause. All transactions are concluded when $\overline{\text{FRAME}}$ and $\overline{\text{IRDY}}$ are both negated, which indicates that the bus is idle.

7.4.3.1 Master-Initiated Termination

Normally, to initiate termination a master negates $\overline{\text{FRAME}}$ and asserts $\overline{\text{IRDY}}$, which indicates to the target that the final data phase is in progress. The final data transfer occurs when both $\overline{\text{TRDY}}$ and $\overline{\text{IRDY}}$ are asserted. The transaction is considered complete when data is transferred in the last data phase. After the final data phase, both $\overline{\text{FRAME}}$ and $\overline{\text{IRDY}}$ are negated and the bus becomes idle.

The three types of master-initiated termination are the following:

- Completion—Refers to termination when the initiator has concluded its intended transaction, and is the most common reason for termination.
- Timeout—Refers to termination when the initiator loses its bus grant ($\overline{\text{GNT}}$*n* is negated) and its internal latency timer has expired. The intended transaction is not necessarily concluded.
- Master-Abort—An abnormal case of master-initiated termination. If no device (including the subtractive decoding agent) asserts $\overline{\text{DEVSEL}}$ to claim a transaction, the initiator terminates the transaction with a master-abort. For a master-abort termination, the initiator negates $\overline{\text{FRAME}}$ and then negates $\overline{\text{IRDY}}$ on the next clock. If a transaction is terminated by master-abort (except for a special-cycle command), the received master-abort bit (bit 13) of the PCI status register is set.

As an initiator, if the MPC8245 does not detect the assertion of $\overline{\text{DEVSEL}}$ within four clock cycles following the address phase (five clock cycles after asserting $\overline{\text{FRAME}}$), it terminates the transaction with a master-abort. On reads that are master-aborted, the MPC8245 returns all ones (0xFFFF). On writes that are master-aborted, the data is lost.

7.4.3.2 Target-Initiated Termination

By asserting the $\overline{\text{STOP}}$ signal, a target may request that the initiator should terminate the current transaction. When asserted, the target holds $\overline{\text{STOP}}$ asserted until the initiator negates $\overline{\text{FRAME}}$. Data may or may not be transferred during the request for termination. If $\overline{\text{TRDY}}$ and $\overline{\text{IRDY}}$ are asserted during the assertion of $\overline{\text{STOP}}$, data is transferred. However, if $\overline{\text{TRDY}}$ is negated when $\overline{\text{STOP}}$ is asserted, it indicates that the target will not transfer any more data. The initiator does not wait for a final data transfer as it would in a completion termination.

When a transaction is terminated by $\overline{\text{STOP}}$, the initiator must negate its $\overline{\text{REQ}}n$ signal for a minimum of two PCI clock cycles, (one corresponding to the point that the bus goes to the idle state and $\overline{\text{FRAME}}$ and $\overline{\text{IRDY}}$ are negated). If the initiator intends to complete the transaction, it can reassert its $\overline{\text{REQ}}n$ immediately following the two clock cycles. If the initiator does not intend to complete the transaction, it can assert $\overline{\text{REQ}}n$ whenever it needs to use the PCI bus again.

The following are three types of target-initiated termination:

- Disconnect—*Disconnect* refers to a termination request because the target is temporarily unable to continue bursting. Disconnect implies that some data has been transferred. The initiator may restart the transaction at a later time, starting with the address of the next untransferred data. (That is, data transfer may resume where it stopped.)
- Retry—*Retry* refers to a termination request because the target is currently in a state where it is unable to process the transaction. Retry implies that no data was transferred. The initiator may restart the entire transaction at a later time. Note that the *PCI Local Bus Specification*, Rev. 2.2, requires that all retried transactions must be completed.
- Target-Abort—*Target-abort* is an abnormal case of target-initiated termination. Target-abort is used when a fatal error occurred or when a target will never be able to respond.

7.4.3.2.1 Target-Disconnect Termination

As a target, the MPC8245 terminates a transaction with a target-disconnect under the following conditions:

- It is unable to respond within eight PCI clock cycles (not including the first data phase).
- A cache line (32 bytes) of data is transferred for a cache-wrap mode read transaction. (See the discussion of cache wrap mode in Section 7.3.3.1, “Memory Space Addressing,” for more information.)
- A single beat of data is transferred for a cache-wrap mode write transaction. (See the discussion of cache wrap mode in Section 7.3.3.1, “Memory Space Addressing,” for more information.)
- If AD[1:0] = 0b01 or AD[1:0] = 0b11 during the address phase of a local memory access. (See Section 7.3.3.1, “Memory Space Addressing,” for more information.)

PCI masters can write to the local or extended ROM/Flash interface using the PCI bus. The MPC8245 as a target issues a disconnect after accepting one or two beats of data, depending on the size of the peripheral logic bus (32- or 64-bit mode), which is configured by the setting of MDL[0] at reset.

The disconnect timing for these cases is shown in Table 7-4.

Table 7-4. Disconnect Timing for PCI Write to Local/Extended ROM

PCI Data Bus Width	Peripheral Logic Data Bus Width	
	32-Bit	64-Bit
32-Bit Data Bus on PCI	After 1 beat	After 2 beats

Note that when the peripheral logic bus is operating in 64-bit mode, the MPC8245 disconnects after receiving two beats of data on PCI. In this case, software should align the write address to a quad-word boundary. For more information about writing to the ROM/Flash, refer to Section 6.3.3, “ROM/Flash Interface Write Operations.”

7.4.3.2.2 Retry Termination

As a target, the MPC8245 responds to a transaction with a retry due to the following reasons:

- A processor copyback operation is in progress.
- A PCI write to local memory was attempted when the internal PCI-to-local-memory-write buffers (PCMWBs) were full.
- A nonexclusive access was attempted to local memory while the MPC8245 was locked.
- A configuration write to a PCI device is underway and PICR2[NO_SERIAL_CFG] = 0.
- An access to one of the MPC8245 internal configuration registers is in progress.
- The 16-clock latency timer expired and the first data phase has not begun.

7.4.3.2.3 Target-Abort Termination

Target-abort is indicated by asserting $\overline{\text{STOP}}$ and negating $\overline{\text{DEVSEL}}$, which indicates that the target requires termination of the transaction and does not want the transaction retried. If target-abort terminates a transaction, the received target-abort bit (bit 12) of the initiator’s status register and the signaled target-abort bit (bit 11) of the target’s status register are set. Note that any data that is transferred in a target-aborted transaction might be corrupt.

For PCI writes to local memory, if an address parity error or data parity error occurs, the MPC8245 aborts the transaction internally but continues the transaction on the PCI bus.

Figure 7-7 on page 7-22 shows several target-initiated terminations. The three disconnect terminations are unique in the data transferred at the end of the transaction:

- For Disconnect A, the initiator is negating $\overline{\text{IRDY}}$ when the target asserts $\overline{\text{STOP}}$. Data is transferred only at the end of the current data phase.

- For Disconnect B, the target negates $\overline{\text{TRDY}}$ one clock after it asserts $\overline{\text{STOP}}$, indicating that the target can accept the current data, but additional data can be transferred.
- For Disconnect-Without-Data, the target asserts $\overline{\text{STOP}}$ when $\overline{\text{TRDY}}$ is negated, indicating that the target cannot accept any more data.

7.4.4 Fast Back-to-Back Transactions

The PCI bus allows the same master to make fast back-to-back transactions. During a fast back-to-back transaction, the initiator starts the next transaction immediately without an idle state. The last data phase completes when $\overline{\text{FRAME}}$ is negated, and $\overline{\text{IRDY}}$ and $\overline{\text{TRDY}}$ are asserted. The current master starts another transaction in the clock cycle immediately following the last data transfer for the previous transaction.

Fast back-to-back transactions must avoid contention on the $\overline{\text{TRDY}}$, $\overline{\text{DEVSEL}}$, $\overline{\text{PERR}}$, and $\overline{\text{STOP}}$ signals. The two types of fast back-to-back transactions are those that access the same target and those that access multiple targets sequentially. The first type places the burden of avoiding contention on the initiator; the second type places the burden of avoiding contention on all potential targets.

As an initiator, the MPC8245 does not perform any fast back-to-back transactions. As a target, the MPC8245 supports both types of fast back-to-back transactions.

During fast back-to-back transactions, the MPC8245 monitors the bus states to determine if it is the target of a transaction. If the previous transaction was not directed to the MPC8245 and the current transaction is directed at the MPC8245, it delays the assertion of $\overline{\text{DEVSEL}}$ (as well as $\overline{\text{TRDY}}$, $\overline{\text{STOP}}$, and $\overline{\text{PERR}}$) for one clock cycle to allow the other target to stop driving the bus.

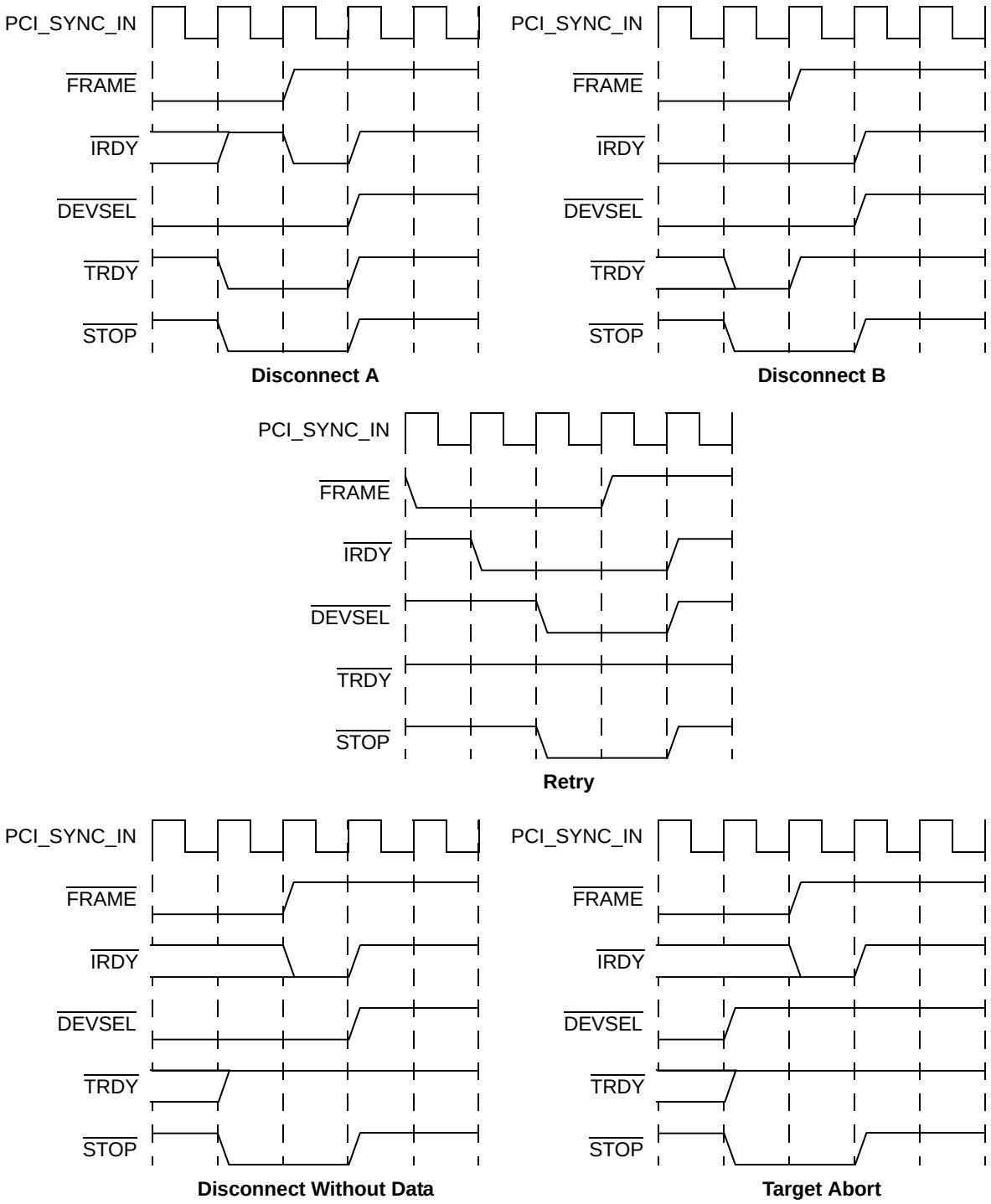


Figure 7-7. PCI Target-Initiated Terminations

7.4.5 Dual Address Cycles (Master-Only)

The MPC8245 supports dual address cycle (DAC) commands (64-bit addressing on PCI bus) as a master. DACs are different from single address cycles (SACs) in that the address phase takes two PCI beats instead of one PCI beat to transfer (64-bit vs. 32-bit addressing). Only PCI memory commands can use DAC cycles; I/O, configuration, interrupt acknowledge, and special cycle command cannot use DAC cycles. The MPC8245 supports single-beat and burst DAC transactions. The local processor or DMA channels can start a DAC cycle on the PCI bus.

For the case of the local processor, DAC generation depends on the setting of the OTHBARx. If the OTHBARx are programmed with nonzero values and a transaction from the processor core hits in one of the outbound windows, a DAC transaction is generated on the PCI bus with the translated lower 32-bit addresses. Refer to Section 3.3.2, “Outbound PCI Address Translation,” for more information.

For DMA channels, the DAC generation depends on the types of transfers and the setting of the high order address registers. In this case, if the corresponding high order address register (see Chapter 8, “DMA Controller) is nonzero, a DAC transaction is generated regardless of whether the transaction hits in the outbound windows.

The figures show the following information:

- Figure 7-8 shows the timing sequence of the PCI signals for single-beat DAC reads
- Figure 7-9 shows timing for a DAC burst read
- Figure 7-10 and Figure 7-11 show timing examples for single-beat DAC writes and burst DAC writes, respectively.

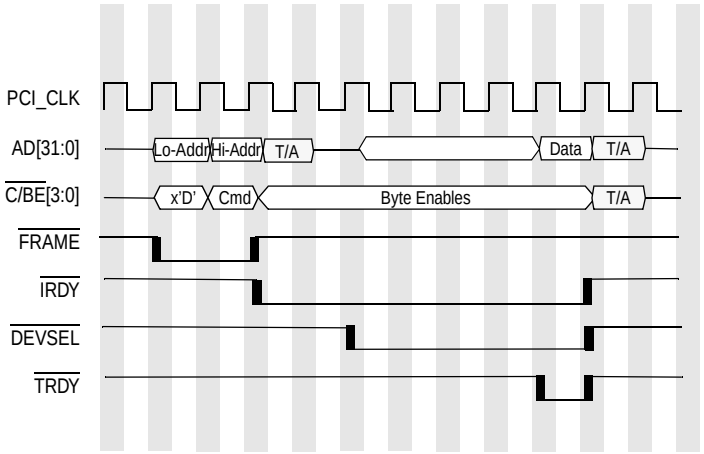


Figure 7-8. DAC Single-Beat Read Example

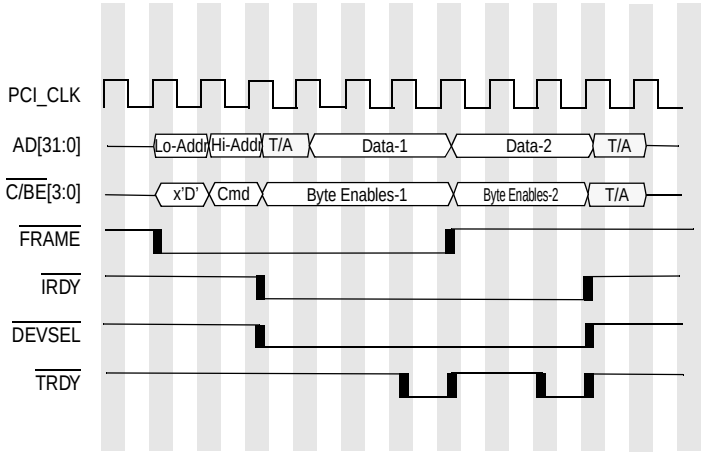


Figure 7-9. DAC Burst Read Example

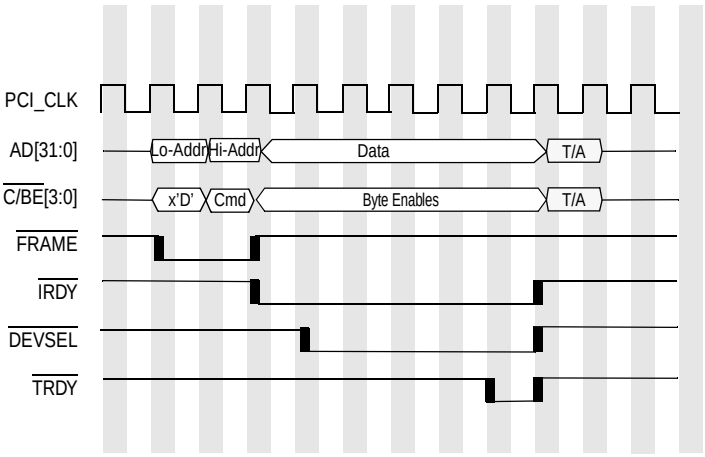


Figure 7-10. DAC Single-Beat Write Example

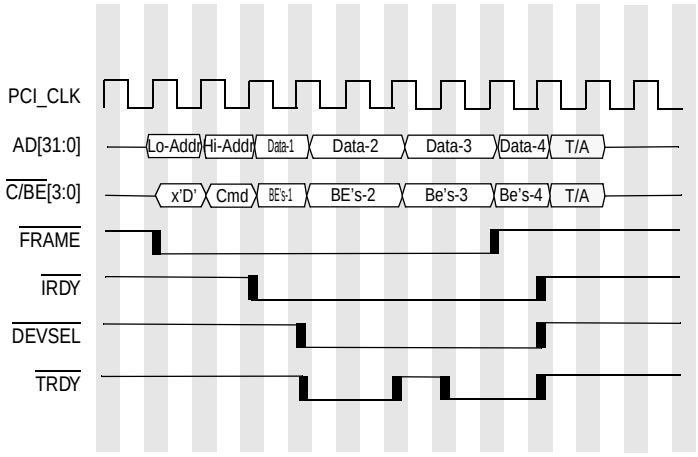


Figure 7-11. DAC Burst Write Example

7.4.6 Configuration Cycles

This section describes PCI configuration cycles for configuring standard PCI devices. The PCI configuration space of any device is intended for configuration, initialization, and catastrophic error-handling functions only. Access to the PCI configuration space should be limited to initialization and error-handling software.

7.4.6.1 PCI Configuration Space Header

The first 64 bytes of the 256-byte configuration space consist of a predefined header that every PCI device must support. The predefined header is shown in Figure 7-12. The rest of the 256-byte configuration space is specific to a device.

The first 16 bytes of the predefined header are defined similarly for all PCI devices. The remaining 48 bytes of the header may have differing layouts, depending on the function of the device. Most PCI devices use the configuration header layout shown in Figure 7-12.

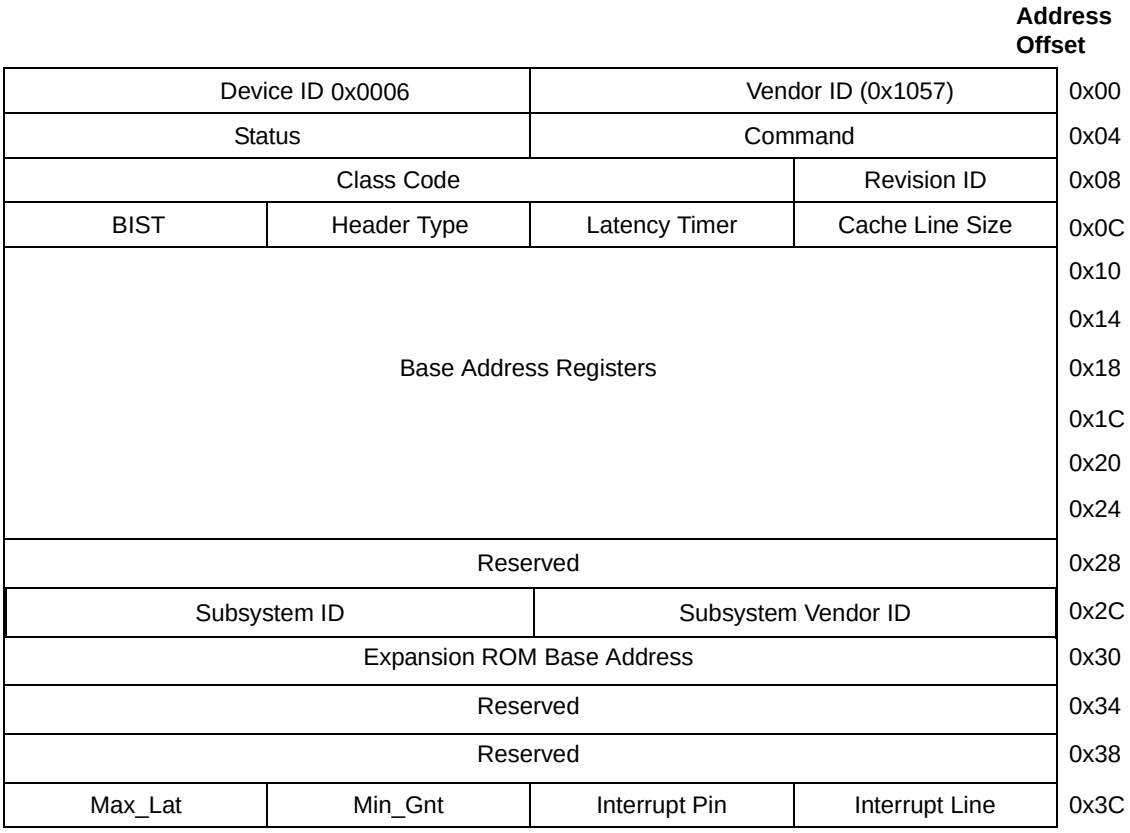


Figure 7-12. Standard PCI Configuration Header

Table 7-5 summarizes the configuration header registers. Detailed descriptions of these registers are provided in the *PCI Local Bus Specification*, Rev. 2.2.

Table 7-5. PCI Configuration Space Header Summary

Address Offset (Hex)	Register Name	Description
0x00	Vendor ID	Identifies the manufacturer of the device (assigned by the PCI SIG (special-interest group) to ensure uniqueness). Set to 0x1057 for MPC8245.
0x02	Device ID	Identifies the particular device (assigned by the vendor). Set to 0x0006 for MPC8245.
0x04	Command	Provides coarse control over a device's ability to generate and respond to PCI bus cycles
0x06	Status	Records status information for PCI bus-related events
0x08	Revision ID	Specifies a device-specific revision code (assigned by vendor)
0x09	Class code	Identifies the generic function of the device and (in some cases) a specific register-level programming interface
0x0C	Cache line size	Specifies the system cache line size in 32-bit units
0x0D	Latency timer	Specifies the value of the latency timer in PCI bus clock units for the device when acting as an initiator
0x0E	Header type	Bits 0–6 identify the layout of bytes 10–3F; bit 7 indicates a multifunction device. The most common header type (0x00) is shown in Figure 7-12 and in this table.
0x0F	BIST	Optional register for control and status of built-in self test (BIST)
0x10–0x27	Base address registers	Address mapping information for memory and I/O space
0x28	—	Reserved for future use
0x2C	Subsystem Vendor ID	Identifies the subsystem vendor ID. Initial value for MPC8245 set by the MDH[16:31] reset configuration signals.
0x2E	Subsystem ID	Identifies the subsystem ID. Initial value for MPC8245 set by the MDH[0:15] reset configuration signals.
0x30	Expansion ROM base address	Base address and size information for expansion ROM contained in an add-on board
0x34	—	Reserved for future use
0x38	—	Reserved for future use
0x3C	Interrupt line	Contains interrupt line routing information
0x3D	Interrupt pin	Indicates which interrupt pin the device (or function) uses
0x3E	Min_Gnt	Specifies the length of the device's burst period in 0.25 µs units
0x3F	Max_Lat	Specifies how often the device needs to gain access to the bus in 0.25 µs units

7.4.6.2 Accessing the PCI Configuration Space

This section describes accessing the external PCI configuration space. See Section 7.7.2, “Accessing the MPC8245 Configuration Space,” for information about accessing the internal configuration registers of the MPC8245.

Two types of configuration accesses support hierarchical bridges:

Configuration access type 0 selects a device on the local PCI bus. Type 0 configuration accesses are not propagated beyond the local PCI bus and must be claimed by a local device or terminated with a master-abort.

Configuration access type 1 passes a configuration request to another PCI bus (through a PCI-to-PCI bridge). Type 1 accesses are ignored by all targets except PCI-to-PCI bridges.

To access the configuration space, a 32-bit value must be written to the CONFIG_ADDR register that specifies the target PCI bus, the target device on that bus, and the configuration register to be accessed within that device. A read or write to the CONFIG_DATA register causes the host bridge to translate the access into a PCI configuration cycle (if the enable bit in CONFIG_ADDR is set and the device number is not 0b1_1111).

The processor accesses the CONFIG_ADDR register at any location in the address range from 0xFEC0_0000 to 0xFEDF_FFFF. Figure 7-13 shows the format of CONFIG_ADDR.

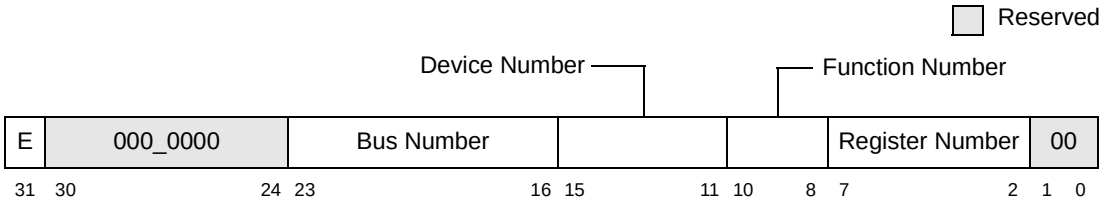


Figure 7-13. CONFIG_ADDR Register Format

Table 7-6 describes the fields within CONFIG_ADDR.

Table 7-6. CONFIG_ADDR Register Fields

Bits	Field Name	Description
31	E(nable)	The enable flag controls whether accesses to CONFIG_DATA are translated into PCI configuration cycles. 1 Enabled 0 Disabled
30–24	—	Reserved (must be 0b000_0000)
23–16	Bus number	This field is an encoded value for selecting the target bus of the configuration access. For target devices on the PCI bus connected to the MPC8245, this field should be set to 0x00.
15–11	Device number	Use this field to select a specific device on the target bus.
10–8	Function number	Use this field to select a specific function in the requested device. Single-function devices should respond to function number 0b000.

Table 7-6. CONFIG_ADDR Register Fields (continued)

Bits	Field Name	Description
7–2	Register number	Use this field to select the address offset in the configuration space of the target device.
1–0	—	Reserved (must be 0b00)

The processor accesses the CONFIG_DATA register at any location in the address range from 0xFEE0_0000 to 0xFEEF_FFFF. Note that the CONFIG_DATA register may contain 1, 2, 3, or 4 bytes depending on the size of the register being accessed.

When the MPC8245 detects an access to the CONFIG_DATA register, it checks the enable flag and the device number in the CONFIG_ADDR register. If the enable bit is set and the device number is not 0b1_1111, the MPC8245 performs a configuration cycle translation function and runs a configuration-read or configuration-write transaction on the PCI bus. The device number 0b1_1111 is used for performing interrupt-acknowledge and special-cycle transactions. See Section 7.4.7, “Other Bus Transactions,” for more information.

If the bus number corresponds to the local PCI bus (bus number = 0x00), the MPC8245 performs a type 0 configuration cycle translation. If the bus number indicates a remote PCI bus (that is, nonlocal), the MPC8245 performs a type 1 configuration cycle translation.

7.4.6.2.1 Type 0 Configuration Translation

Figure 7-14 shows the type 0 translation function performed on the contents of the CONFIG_ADDR register to the AD[31:0] signals on the PCI bus during the address phase of the configuration cycle.

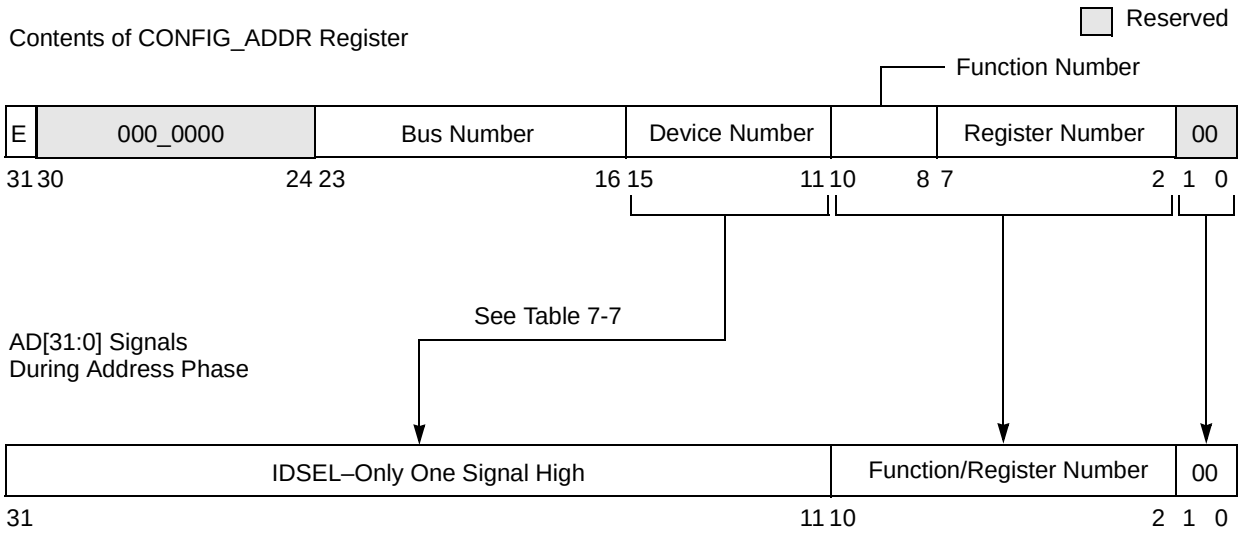


Figure 7-14. Type 0 Configuration Translation

For type 0 configuration cycles, the MPC8245 translates the device number field of the CONFIG_ADDR register into a unique IDSEL signal for up to 21 different devices. Each

device connects its IDSEL input to one of the AD[31:11] signals. For type 0 configuration cycles, the MPC8245 translates the device number to IDSEL as shown in Table 7-7.

Table 7-7. Type 0 Configuration—Device Number to IDSEL Translation

Device Number		IDSEL
Binary	Decimal	
0b0_0000–0b0_1001	0–9	—
0b0_1010	10	AD31
0b0_1011	11	AD11
0b0_1100	12	AD12
0b0_1101	13	AD13
0b0_1110	14	AD14
0b0_1111	15	AD15
0b1_0000	16	AD16
0b1_0001	17	AD17
0b1_0010	18	AD18
0b1_0011	19	AD19
0b1_0100	20	AD20
0b1_0101	21	AD21
0b1_0110	22	AD22
0b1_0111	23	AD23
0b1_1000	24	AD24
0b1_1001	25	AD25
0b1_1010	26	AD26
0b1_1011	27	AD27
0b1_1100	28	AD28
0b1_1101	29	AD29
0b1_1110	30	AD30
0b1_1111 [1]	31	—

[1] A device number of all ones indicates a PCI special-cycle or interrupt-acknowledge transaction.

For type 0 translations, the function number and register number fields are copied without modification onto the AD[10:2] signals during the address phase. The AD[1:0] signals are driven to 0b00 during the address phase for type 0 configuration cycles.

7.4.6.2.2 Type 1 Configuration Translation

For type 1 translations, the MPC8245 copies the 30 high-order bits of the CONFIG_ADDR register (without modification) onto the AD[31:2] signals during the address phase. The MPC8245 automatically translates AD[1:0] into 0b01 during the address phase to indicate a type 1 configuration cycle.

7.4.7 Other Bus Transactions

The MPC8245 supports two other PCI transactions, which are *interrupt acknowledge* and *special cycles*. As an initiator, the MPC8245 may initiate both interrupt acknowledge and special-cycle transactions. However, as a target, the MPC8245 ignores interrupt-acknowledge and special-cycle transactions. Both transactions use the CONFIG_ADDR and CONFIG_DATA registers described in Section 7.4.6.2, “Accessing the PCI Configuration Space.”

7.4.7.1 Interrupt-Acknowledge Transactions

The PCI bus supports an interrupt-acknowledge transaction. The interrupt-acknowledge command is a read operation implicitly addressed to the system interrupt controller. Note that the PCI interrupt-acknowledge command does not address the MPC8245 PIC processor interrupt-acknowledge register and does not return the interrupt vector address from the PIC unit. See Chapter 11, “Programmable Interrupt Controller (PIC) Unit,” for more information about the PIC unit.

When the MPC8245 detects a read to the CONFIG_DATA register, it checks the enable flag and the device number in the CONFIG_ADDR register. When the following conditions are all true, the MPC8245 performs an interrupt-acknowledge transaction:

- The enable bit is set.
- The bus number corresponds to the local PCI bus (bus number = 0x00).
- The device number is all ones (0b1_1111).
- The function number is all ones (0b111).
- The register number is zero (0b00_0000).

If the bus number indicates a nonlocal PCI bus, the MPC8245 performs a type 1 configuration cycle translation, similar to any other configuration cycle for which the bus number does not match.

The address phase contains no valid information other than the interrupt-acknowledge command ($\overline{\text{C/BE}}$[3:0] = 0b0000). Although there is no explicit address, AD[31:0] are driven to a stable state, and parity is generated. Only one device (the system interrupt controller) on the PCI bus should respond to the interrupt-acknowledge command by asserting $\overline{\text{DEVSEL}}$. All other devices on the bus should ignore the interrupt-acknowledge

command. The MPC8245 PIC unit does not respond to PCI interrupt-acknowledge commands.

During the data phase, the responding device returns the interrupt vector on AD[31:0] when $\overline{\text{TRDY}}$ is asserted. The value driven on the $\overline{\text{C/BE}}$[3:0] signals indicates the size of the returned interrupt vector.

The MPC8245 also provides a direct method for generating PCI interrupt-acknowledge transactions. For address map B, processor reads to any location in the address range 0xFEF0_0000–0xFEFF_FFFF generate PCI interrupt-acknowledge transactions. Note that processor writes to these addresses cause processor transaction errors; see Section 14.3.1.1, “Processor Transaction Error,” for more information.

7.4.7.2 Special-Cycle Transactions

The special-cycle command provides a mechanism to broadcast select messages to all devices on the PCI bus. The special-cycle command contains no explicit destination address, but is broadcast to all PCI agents.

When the MPC8245 detects a write to the CONFIG_DATA register, it checks the enable flag and the device number in the CONFIG_ADDR register. When the following conditions are all true, the MPC8245 performs a special-cycle transaction on the local PCI bus:

- The enable bit is set.
- The bus number corresponds to the local PCI bus (bus number = 0x00).
- The device number is all ones (0b1_1111).
- The function number is all ones (0b111).
- The register number is zero (0b00_0000).

If the bus number indicates a nonlocal PCI bus, the MPC8245 performs a type 1 configuration cycle translation, similar to any other configuration cycle for which the bus number does not match.

Aside from the special-cycle command ($\overline{\text{C/BE}}$[3:0] = 0b0001) the address phase contains no other valid information. Although there is no explicit address, AD[31:0] are driven to a stable state and parity is generated. During the data phase, AD[31:0] contain the special-cycle message and an optional data field. The special-cycle message is encoded on the 16 least-significant bits (AD[15:0]) The optional data field is encoded on the most-significant 16 lines (AD[31:16]). The PCI SIG steering committee assigns the special-cycle message encodings.

The current list of defined encodings are provided in Table 7-8.

Table 7-8. Special-Cycle Message Encodings

AD[15:0]	Message
0x0000	SHUTDOWN
0x0001	HALT
0x0002	x86 Architecture-specific
0x0003–0xFFFF	—

NOTE

The MPC8245 does not automatically issue a special-cycle message when it enters any of its power-saving modes. Software must issue the appropriate special-cycle message, if needed.

Each receiving agent must determine whether the special-cycle message is applicable. Assertion of $\overline{\text{DEVSEL}}$ in response to a special-cycle command is not necessary. The initiator of the special-cycle transaction can insert wait states. But because no specific target exists, the special-cycle message and optional data field are valid on the first clock $\overline{\text{IRDY}}$ is asserted. Master-abort terminates all special-cycle transactions. However, the master-abort bit in the initiator's status register is not set for special-cycle terminations.

7.5 Exclusive Access

PCI provides an exclusive access mechanism called a *resource lock*. The mechanism locks only the selected PCI resource (typically memory) but allows other nonexclusive accesses to unlocked targets. In this section, the term *locked operation* means an exclusive access to a locked target that may span several PCI transactions. A full description of exclusive access is contained in the *PCI Local Bus Specification,* Rev. 2.2.

7.5.1 Starting an Exclusive Access

To initiate a locked operation, an initiator must receive mastership of the bus when the $\overline{\text{LOCK}}$ signal is not busy. The initiator then owns the $\overline{\text{LOCK}}$ signal. To request a resource lock, the initiator must hold $\overline{\text{LOCK}}$ negated during the address phase of a read command and assert $\overline{\text{LOCK}}$ in the clock cycle following the address phase.

NOTE

The first transaction of a locked operation must be a read transaction.

The locked operation is not established on the PCI bus until the first data transfer ($\overline{\text{IRDY}}$ and $\overline{\text{TRDY}}$ asserted) completes. When the lock is established, the initiator may retain

ownership of the $\overline{\text{LOCK}}$ signal and the target may remain locked beyond the end of the current transaction. The initiator holds $\overline{\text{LOCK}}$ asserted until either the locked operation completes or until an error (master-abort or target-abort) causes an early termination. A target remains in the locked state until both $\overline{\text{FRAME}}$ and $\overline{\text{LOCK}}$ are negated. If the target retries the first transaction without a data phase completing, the initiator should not only terminate the transaction but also negate $\overline{\text{LOCK}}$.

7.5.2 Continuing an Exclusive Access

When the lock owner is granted access to the bus for another exclusive access to the previously-locked target, it negates the $\overline{\text{LOCK}}$ signal during the address phase to reestablish the lock. The locked target accepts the transaction and claims the transaction. The initiator then asserts $\overline{\text{LOCK}}$ in the clock cycle following the address phase. If the initiator plans to continue the locked operation, it continues to assert $\overline{\text{LOCK}}$.

7.5.3 Completing an Exclusive Access

When an initiator is ready to complete an exclusive access, it should negate $\overline{\text{LOCK}}$ when $\overline{\text{IRDY}}$ is negated following the completion of the last data phase of the locked operation. This action ensures that the target is released before any other operation and the resource is no longer blocked.

7.5.4 Attempting to Access a Locked Target

If $\overline{\text{LOCK}}$ is asserted during the address phase to a locked target, the locked target signals a retry, terminating the transaction without transferring any data. (The lock master always negates $\overline{\text{LOCK}}$ during the address phase of a transaction to a locked target.) Nonlocked targets ignore the $\overline{\text{LOCK}}$ signal when decoding the address to allow other PCI agents to initiate and respond to transactions while maintaining exclusive access to the locked target.

7.5.5 Exclusive Access and the MPC8245

As an initiator, the MPC8245 does not generate locked operations. As a target, the MPC8245 responds to locked operations by guaranteeing complete access exclusion to local memory from the point-of-view of the PCI bus. From the point of view of the processor core, only the cache line (32 bytes) of the transaction is locked.

If an initiator on the PCI bus asserts $\overline{\text{LOCK}}$ for a read transaction to local memory, the MPC8245 completes the snoop transactions for any previous PCI-to-local-memory write operations and performs a snoop transaction for the locked read operation on the internal peripheral logic bus. Subsequent processor core accesses to local memory, when $\overline{\text{LOCK}}$ is asserted, are permitted except that if the processor core attempts to access addresses within the locked cache line, the MPC8245 retries the processor until the locked operation is completed. If a locked operation covers more than one cache line (32 bytes), only the most

recently accessed cache line is locked from the processor. Because a snoop transaction is required to establish a lock, the MPC8245 does not honor the assertion of $\overline{\text{LOCK}}$ when PICR1[NO_SNOOP_EN] is set.

Note that as a default (for PCI 2.2 compatible), the MPC8245 only responds to $\overline{\text{LOCK}}$ if it is in host mode. However, a bit in the PCI General Control register controls the support of $\overline{\text{LOCK}}$, and this bit can be programmed to overwrite this default functionality. Refer to Section 4.2.11, “PCI General Control Register (PGCR)—Offset 0x44.”

7.6 PCI Error Functions

PCI provides for parity and other system errors to be detected and reported. This section describes generation and detection of parity and error reporting for the PCI bus.

The PCI command register and error enabling registers 1 and 2 provide for selective enabling of specific PCI error detection. The PCI status register, error detection registers 1 and 2, the PCI bus error status register, and the 60x/PCI error address register provide PCI error reporting. These registers are described in Chapter 4, “Configuration Registers.”

7.6.1 PCI Parity

Generating parity is not optional; it must be performed by all PCI-compliant devices. All PCI transactions, regardless of type, calculate *even parity*: the number of ones on the AD[31:0], $\overline{\text{C/BE}}$[3:0], and PAR signals all sum to an even number.

Parity provides a way to determine, on each transaction, if the initiator successfully addressed the target and transferred valid data. The $\overline{\text{C/BE}}$[3:0] signals are included in the parity calculation to ensure that the correct bus command is performed (during the address phase) and correct data is transferred (during the data phase). The agent responsible for driving the bus must also drive even parity on the PAR signal one clock cycle after a valid address phase or valid data transfer, as shown in Figure 7-15.

During the address and data phases, parity covers all 32 address/data signals and 4 command/byte enable signals, regardless of whether all lines carry meaningful information. Byte lanes not actually transferring data must contain stable (albeit meaningless) data and are included in parity calculation. During configuration, special-cycle, or interrupt-acknowledge commands; some address lines are not defined, but are driven to stable values and are included in parity calculation.

Agents that support parity checking must set the detected parity error bit in the PCI status register when a parity error is detected. Any additional response to a parity error is controlled by the parity error response bit in the PCI command register. If the parity error response bit is cleared, the agent ignores all parity errors.

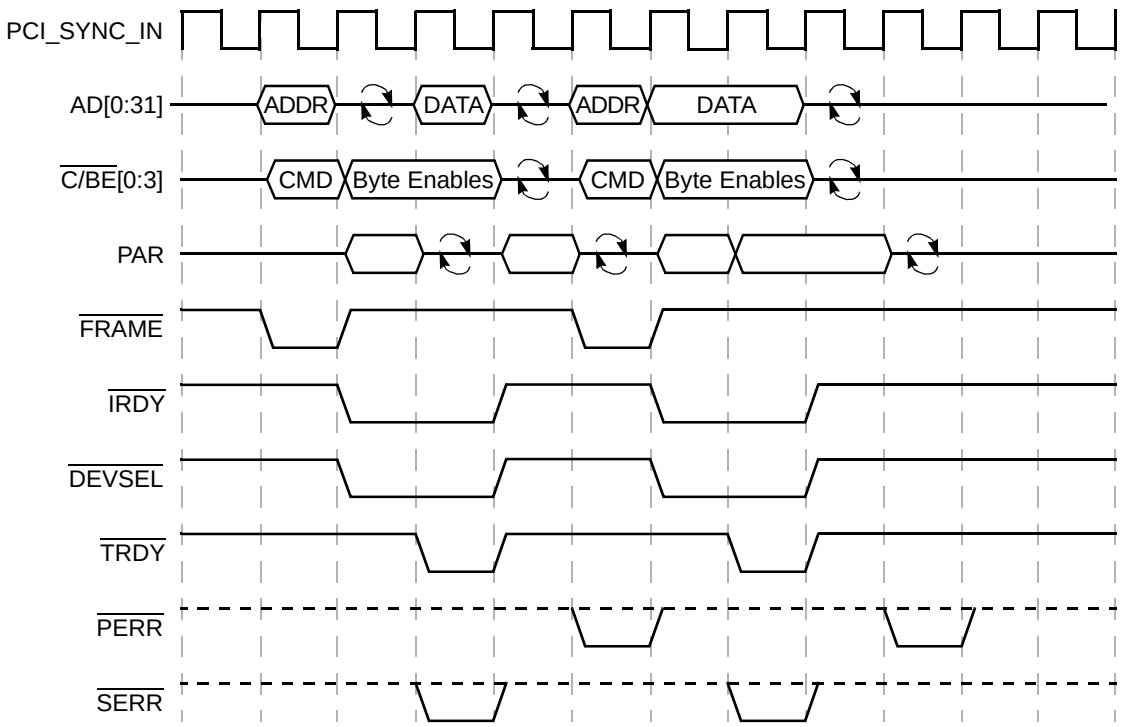


Figure 7-15. PCI Parity Operation

7.6.2 Error Reporting

PCI provides for the detection and signaling of both parity and other system errors. Two signals, PERR and SERR, are used to report these errors. The PERR signal is used exclusively to report data parity errors on all transactions except special cycles. The SERR signal is used for other error signaling including address parity errors and data parity errors on special-cycle transactions. It may also be used to signal other system errors. Refer to Section 14.3.3, “PCI Interface Errors,” for a complete description of MPC8245 actions due to parity and other errors.

7.7 PCI Host and Agent Modes

This section describes the different modes available in the MPC8245.

The MPC8245 can function as either a PCI host bridge (called *host mode*) or a peripheral device on the PCI bus (called *agent mode*). The MAA1 configuration signal, sampled at reset, configures the MPC8245 for host or agent mode as described in Section 2.4, “Configuration Signals Sampled at Reset.” Note that agent mode is supported only for address map B. Also note that in agent mode, the MPC8245 ignores all PCI memory accesses (except to the EUMB) until inbound address translation is enabled. See Section 7.7.4.1, “Inbound PCI Address Translation,” and Section 3.3.1, “Inbound PCI Address Translation,” for more information about inbound address translation.

7.7.1 PCI Initialization Options

The assertion of the HRST_CPU and HRST_CTRL signals (must be asserted together) cause the processor to take a hard reset exception. The physical address of the handler is always 0xFFF0_0100. Host and agent modes provide different options for initial reset exception vector fetching and register configuration.

When the MPC8245 is configured for host mode, the system may initialize by fetching initial instructions from a ROM/Flash device. The setting of the RCS0 configuration signal at the negation of the reset signals determines whether ROM/Flash is located in local memory space or in PCI memory space. See Section 2.4, “Configuration Signals Sampled at Reset,” for more information.

When the MPC8245 is configured for agent mode, it can also be configured to initialize from local memory space or remote PCI memory space.

Table 7-9 summarizes the initialization modes of the MPC8245. The initial settings of the PCI command register bus master and memory space bits (bits 2 and 1, respectively) are determined based on the reset configuration signals that Table 7-9 shows.

Table 7-9. Initialization Options for PCI Controller

Bus Master Mode (MAA1 at Reset)	ROM Location (RCS0 at Reset)	Initial Settings of PCI Command Register and Boot Vector Fetch
Host (**MAA1** high)	Local memory space (RCS0 high)	PCI command register [2,1] set to: 10 Master enabled, target disabled Boot vector fetch is sent to ROM located on the local memory interface.
Host (**MAA1** high)	PCI memory space (RCS0 low)	PCI command register [2,1] set to: 10 Master enabled, target disabled Boot vector fetch is sent to PCI, and is issued on the bus unaltered.
Agent (**MAA1** low)	Local memory space (RCS0 high)	PCI command register [2,1] set to: 00 Master disabled, target disabled Boot vector fetch is sent to ROM located on the local memory bus. Processor core configures local memory and has the option to set bit 10 (RTY_PCI_CFG) of the PCI arbiter control register (PACR) to force PCI configuration cycles to be retried until local configuration is complete (see Section 7.7.3, “PCI Configuration Cycle Retry Capability in Agent Mode”). The MPC8245 cannot issue transactions on the PCI bus until the master enable bit is set.
Agent (**MAA1** low)	PCI memory space (RCS0 low)	PCI command register [2,1] set to: 00 Master disabled, target disabled Boot vector fetch is sent to PCI bus where it is not allowed to proceed until the host CPU enables bus mastership for the MPC8245 in the PCI control register. The processor core then proceeds, sending the boot vector fetch to the PCI bus unaltered.

7.7.2 Accessing the MPC8245 Configuration Space

The MPC8245 responds to PCI configuration accesses from external PCI agents when the MPC8245 IDSEL input signal is asserted. This action allows an external agent access to a

subset of the MPC8245 internal configuration registers. The configuration of the internal registers of the MPC8245 that are not accessible to external agents is described in Section 4.1, “Configuration Register Access.”

When accessing the MPC8245 configuration registers, the external agent performs the translation that Figure 7-14 shows. The external agent uses the appropriate device number to assert the MPC8245 IDSEL input. The function/register numbers from 0x00 to 0x47 are described in Section 4.1.3.2, “PCI-Accessible Configuration Registers.”

7.7.3 PCI Configuration Cycle Retry Capability in Agent Mode

When the MPC8245 is configured for agent mode and is initializing from ROM located on the local memory bus, it may be necessary to defer a remote host from completing PCI configuration cycles until the local device can be tested and configured.

When the MPC8245 RTY_PCI_CFG bit (bit 10 in PACR) is set, the MPC8245 PCI bus interface retries PCI configuration cycles. This mechanism allows the processor core to complete configuration of the local memory controller in advance of a system host controller. When the MPC8245 completes local configuration, it can clear the RTY_PCI_CFG bit, enabling the system host controller to complete configuration.

7.7.4 PCI Address Translation Support

The MPC8245 allows remapping PCI memory space transactions to local memory and processor core transactions to PCI memory space. Note that address translation is supported in both host and agent mode. The following sections summarize the address translation support of the MPC8245. See Section 3.3, “Address Translation,” for more information about the MPC8245 address translation facility.

7.7.4.1 Inbound PCI Address Translation

Inbound transactions are PCI memory space accesses that an external PCI master initiates that are targeted toward the MPC8245. Using inbound address translation, the MPC8245 claims the PCI memory space transaction and translates it to a local memory access. When the MPC8245 is in agent mode, inbound address translation allows an external PCI master to access local memory through a window in the PCI memory space.

Note that in agent mode, the MPC8245 ignores all PCI accesses to local memory until inbound address translation is enabled. That is, in agent mode, the MPC8245 responds only to the PCI configuration and to the embedded utilities memory block (EUMB) accesses until inbound translation is enabled. See Section 3.3.1, “Inbound PCI Address Translation,” for a complete description of inbound PCI address translation.

7.7.4.2 Outbound PCI Address Translation

Outbound transactions are accesses that the processor core initiates that are targeted to PCI memory space. Using outbound address translation, the processor transaction is translated to an address in PCI memory space. When the MPC8245 is in agent mode, outbound address translation allows the MPC8245 to access (external) host memory in the lower 2 Gbytes of PCI memory space. See Section 3.3.2, “Outbound PCI Address Translation,” for a complete description of outbound PCI address translation.

7.7.4.3 Initialization Code Translation in Agent Mode

Because the processor always vectors to 0xFFF0_0100 after a hard reset, it may be preferable in some systems to fetch from an alternate or translated address space. This factor allows a system designer to place the initialization code at some alternate system memory location such as system main memory or alternate system ROM space. When configured for agent mode, outbound PCI address translation accomplishes this task.

The MPC8245 can be programmed from a remote host controller. In this case, the outbound translation window is set to map the local ROM space to an alternate system address. Use the following procedure to take advantage of this functionality:

1. MPC8245 is configured for agent mode with ROM located in PCI memory space.
2. System performs a hard reset.
3. The MPC8245 processor core fetches the hard reset exception vector that is directed to the PCI bus. The transaction stalls and cannot proceed until the PCI command register master enable bit is enabled.
4. The system host controller initializes and configures the MPC8245 as an agent.
5. The host must program PCSRBAR to locate the EUMB within PCI memory space.
6. The host must set bit 1 of the PCI command register to enable MPC8245 response to PCI memory accesses.
7. The host programs the outbound translation window to contain the ROM space and the outbound translation base address to point to the location in system (PCI memory) space where the initialization code resides.
8. The host then sets the PCI control register master enable bit in the MPC8245 to allow the local processor reset vector fetch (stalled in step 3) to initiate a read from the translated PCI location (as set up in step 7).
9. The MPC8245 completes the pending reset exception fetch from the translated system address and configures the local memory registers (described in Section 4.6, “Memory Interface Configuration Registers”) and the inbound translation registers (ITWR and LMBAR) as described in Section 3.3.4, “Address Translation Registers.”

Chapter 8
DMA Controller

This chapter describes the MPC8245 DMA controller, including the following information:

- Operation of the two DMA channels
- Function of the DMA transfer types
- DMA descriptors' formatting
- Programming details for the DMA registers and their features

8.1 DMA Overview

The MPC8245 DMA controller transfers blocks of data that are independent of the local processor or PCI hosts. Data movement occurs on the PCI or memory bus. The MPC8245 has two DMA channels, each with a 64-byte queue to facilitate gathering and sending data. Both the local processor and PCI masters can initiate a DMA transfer. The MPC8245 DMA unit includes the following features:

- Two DMA channels (0 and 1), both accessible by processor core and remote PCI masters
- Misaligned transfer capability
- Chaining mode (including scatter gathering)
- Direct mode
- Interrupt on completed segment, chain, and error conditions
- Four DMA transfer types:
  - Local memory-to-local memory
  - PCI memory-to-PCI memory
  - PCI memory-to-local memory
  - Local memory-to-PCI memory
- PCI dual address cycle (DAC) support

The DMA controller functions as a PCI agent for the other MPC8245 internal resources.

Figure 8-1 provides a block diagram of the MPC8245 DMA controller.

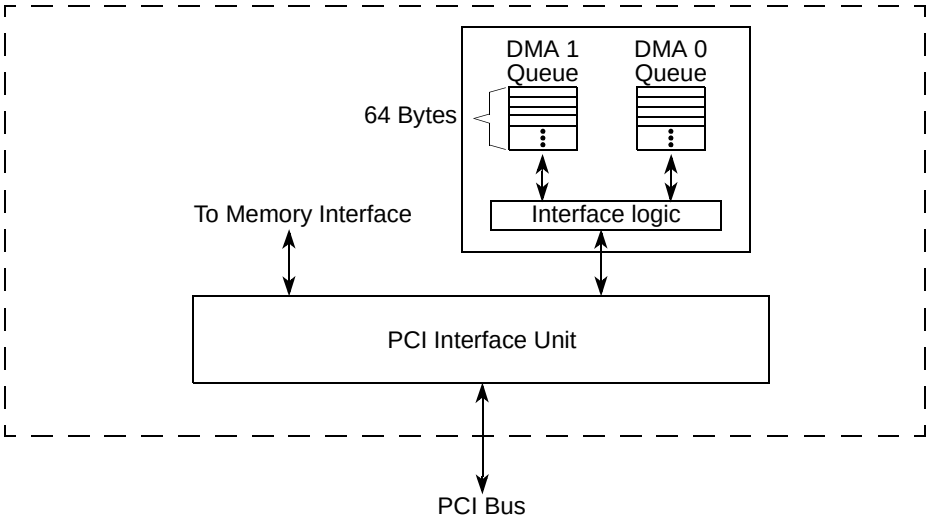


Figure 8-1. DMA Controller Block Diagram

8.2 DMA Register Summary

The MPC8245 has two complete sets of DMA registers, one each for channel 0 and channel 1.

The MPC8245 DMA registers are memory-mapped and comprise part of its embedded utilities. The PCSRBAR for accesses from PCI memory space and the EUMBBAR for accesses from local memory determine the base addresses for the DMA registers. See Section 3.4, “Embedded Utilities Memory Block (EUMB),” for more information.

The two MPC8245 DMA channels are identical, except that the registers for channel 0 are located at offsets 0x100 (PCI) and 0x0_1100 (local), and the registers for channel 1 are located at offsets 0x200 (PCI) and 0x0_1200 (local). Throughout this chapter, a single acronym describes the registers. For example, ‘DMR’ stands for the mode register for either channel 0 or channel 1. Table 8-1 summarizes the DMA registers, all of which are 32 bits wide and accessible from the processor or remote PCI masters in both host and agent mode, as shown.

Table 8-1. DMA Register Summary

PCI Memory Offset	Local Memory Offset	Register Name	Description
0x100	0x0_1100	DMR	DMA 0 mode register. Allows software to set up different DMA modes and interrupt enables.
0x104	0x0_1104	DSR	DMA 0 status register. Tracks DMA processes and errors.
0x108	0x0_1108	CDAR	DMA 0 current descriptor address register. Contains the location of the current descriptor to be loaded.

Table 8-1. DMA Register Summary (continued)

PCI Memory Offset	Local Memory Offset	Register Name	Description
0x10C	0x0_110C	HCDAR	DMA 0 high current descriptor address register. Contains the upper 32-bit address location of the current descriptor to be loaded. This register is valid only when the descriptor is in 64-bit PCI address space.
0x110	0x0_1110	SAR	DMA 0 source address register. Contains the source address where data is read.
0x114	0x0_1114	HSAR	DMA 0 high source address register. Contains the upper 32-bit source address where data is read. The register is valid only when reading from 64-bit PCI address space.
0x118	0x0_1118	DAR	DMA 0 destination address register. Contains the destination address where data is written.
0x11C	0x0_111C	HDAR	DMA 0 high destination address register. Contains the upper 32-bit destination address where data is written. This register is valid only when writing to 64-bit PCI address space.
0x120	0x0_1120	BCR	DMA 0 byte count register. Contains the number of bytes to transfer.
0x124	0x0_1124	NDAR	DMA 0 next descriptor address register. Contains the next descriptor address.
0x128	0x0_1128	HNDAR	DMA 0 high next descriptor address register. Contains the upper 32-bit next descriptor address. This register is valid only when the descriptor is in 64-bit PCI address space.
0x200	0x0_1200	DMR	DMA 1 mode register. Allows software to set up different DMA modes and interrupt enables.
0x204	0x0_1204	DSR	DMA 1 status register. Tracks DMA processes and errors.
0x208	0x0_1208	CDAR	DMA 1 current descriptor address register. Contains the location of the current descriptor to be loaded.
0x20C	0x0_120C	HCDAR	DMA 1 high current descriptor address register. Contains the upper 32-bit address location of the current descriptor to be loaded. This register is valid only when the descriptor is in 64-bit PCI address space.
0x210	0x0_1210	SAR	DMA 1 source address register. Contains the source address where data is read.
0x214	0x0_1214	HSAR	DMA 1 high source address register. Contains the upper 32-bit source address where data is read. This register is valid only when reading from 64-bit PCI address space.
0x218	0x0_1218	DAR	DMA 1 destination address register. Contains the destination address where data is written.
0x21C	0x0_121C	HDAR	DMA 1 high destination address register. Contains the upper 32-bit destination address where data is written.This register is valid only when writing to 64-bit PCI address space.
0x220	0x0_1220	BCR	DMA 1 byte count register. Contains the number of bytes to transfer.

Table 8-1. DMA Register Summary (continued)

PCI Memory Offset	Local Memory Offset	Register Name	Description
0x224	0x0_1224	NDAR	DMA 1 next descriptor address register. Contains the next descriptor address.
0x228	0x0_1228	HNDAR	DMA 1 high next descriptor address register. Contains the upper 32-bit next descriptor address. This register is valid only when the descriptor is in 64-bit PCI address space.

8.3 DMA Operation

The DMA controller operates in two modes—*direct* and *chaining*. In direct mode, the software is responsible for initializing the following registers:

- Source address register (SAR)
- Destination address register (DAR)
- Byte count register (BCR)

In chaining mode, the software must first build descriptor segments in local or remote memory. The current descriptor address register (CDAR) is initialized to point to the first descriptor in memory. In both modes, setting the DMR[CS] bit starts the DMA transfer.

The DMA controller supports misaligned transfers for both the source and destination addresses. It gathers data beginning at the source address and aligns it before sending it to the destination address. The DMA controller assumes that the source and destination addresses are valid PCI or local memory addresses.

All local memory read operations are non-pipelined cache line reads (32 bytes). The DMA controller selects the valid data bytes within a cache line when storing in its queue. The type of write cycles that are performed to local memory depends on the destination address and the number of bytes transferred. The DMA controller attempts to write cache lines (non-pipelined) if the destination address is aligned on a 32-byte boundary. Otherwise, partial cache line writes are performed.

When performing DMA transactions from 64-bit PCI address space, dual address cycles (DACs) fetch data. Upper address registers for descriptor, source, and destination data are used in addition to the registers for 32-bit addressing.

PCI memory read operations depend on the PRC bits in the DMR, the source address, and number of bytes transferred. The DMA controller attempts to read a cache line (32 bytes) whenever possible. All PCI reads are whole beat reads (4 bytes) except when the DMR[SAHE] bit is set (see Table 8-3). Internally, the DMA engine determines the valid bytes within a read and stores them into the queue.

The type of write command for writing to PCI memory depends on the destination address and number of bytes transferred. PCI write-and-invalidate operations are performed only in the following circumstances:

- A full cache line is being transferred.
- PCI command status register (PCSR) bit 4 (memory write and invalidate) is set.
- PCI cache line size register is set to 0x08 (32-byte cache size).

Otherwise, PCI write operations are performed. For maximum performance in most cases, the MPC8245 should be configured to issue write-and-invalidate commands on PCI for DMA accesses. However, the DMA performance still depends on how efficiently the target flushes cached data when a write-and invalidate command occurs.

Because the internal DMA protocols operate on a cache line basis, the MPC8245 always attempts to perform transfers that are the size of a cache line. The only possible exceptions are the first or last transfer. To further enhance performance, the protocols also allow for a multiple-cache-line streaming operation where more than one cache line can be transferred at one time with the possible exception of the first or last burst of a DMA transfer. Maximum performance is achieved when the initial address of a DMA transfer is aligned to a cache-line boundary.

8.3.1 DMA Direct Mode

In direct mode, the DMA controller does not read descriptors from memory, but uses the current parameters in the DMA registers to start a DMA process instead. The DMA transfer is finished after all bytes specified in the BCR are transferred or an error condition occurred. The initialization steps for a DMA transfer in direct mode are as follows:

1. Poll the DSR[CB] bit to make sure the DMA channel is idle.
2. Initialize the SAR, DAR, and BCR.
3. Initialize the CTT bit in the CDAR to indicate the type of transfer.
4. Initialize the CTM bit in the DMR to indicate direct mode. Other control parameters in the DMR can also be initialized here, if necessary.
5. Clear and set the DMR[CS] bit to start the DMA transfer.

DMA registers used for setting up the descriptors in chaining mode also have some implications in direct mode.

In direct mode, the DMA controller can hold the destination address or the source address to a fixed value for every transfer. When the DMR[DAHE] bit is set, the destination address is held, and the DMR[DAHTS] bit indicates the size used for the transfer. When the DMR[SAHE] bit is set, the source address is held and the DMR[SAHTS] bit indicates the size used for transfer. Only one of the DMR[DAHE] or DMR[SAHE] bits may be set at one time. These bits are described in Table 8-3.

8.3.2 DMA Chaining Mode

In chaining mode, the DMA controller loads descriptors from memory before a DMA transfer. The DMA controller begins the transfer according to the descriptor information loaded for the segment. When the current segment is finished, the DMA controller reads the next descriptor from memory and begins another DMA transfer. The process is finished when the current descriptor is the last one in memory or an error condition occurs.

DMA chaining mode can be used to implement *scatter gathering*. In scatter gathering with the MPC8245, a group of descriptors can transfer (scatter) data from a contiguous space of memory to a noncontiguous destination. Similarly, data from a noncontiguous destination can be gathered to a contiguous region of memory.

NOTE

Source and destination address hold are not supported in chaining mode.

8.3.2.1 Basic Chaining Mode Initialization

The initialization steps for a DMA transfer in chaining mode are as follows:

1. Build descriptor segments in memory. Refer to the Section 8.6, “DMA Descriptors for Chaining Mode,” for more information.
2. Poll the DSR[CB] bit to make sure the DMA channel is idle.
3. Initialize the CDAR to point to the first descriptor in memory.
4. Initialize the DMR[CTM] bit to indicate chaining mode. Other control parameters in the DMR can also be initialized here, if necessary.
5. Clear and set the DMR[CS] bit to start the DMA transfer.

If the software dynamically adds more descriptors to a chain that is finished or currently in progress, the DMR[CC] bit should be set to restart the transferring process at the current descriptor address.

8.3.2.2 Periodic DMA Feature

Periodic DMA is a feature that allows a DMA process to be repeated over and over again with the same parameters while in chaining mode. This feature can be useful for applications that require periodic movement of data. The MPC8245 uses two PIC unit timers to signal the DMA channels to start a DMA process automatically without using the processor interrupt. In this mode, timer 2 automatically signals DMA channel 0, and timer 3 automatically signals DMA channel 1.

The following sequence describes the steps to set up the periodic DMA feature:

1. Set up timer 2 or timer 3 with the mask bit in PIC vector priority register set. (When the timer counts down, no interrupt is generated to the processor.) Program the timer to operate at the appropriate rate and clear the CI bit in the corresponding GTBCR. Note that choosing a rate for the timer longer than the time required to complete transferring the DMA chain is wise; otherwise, unpredictable operation occurs. Note that the DMA controller services the timer's request only if the DMA controller is in the idle state (DSR[CB] bit is cleared). If the timer's request occurs while the DMA controller is busy, the request is ignored.
2. Program the DMA channel to operate in chaining mode (see Section 8.3.2.1, "Basic Chaining Mode Initialization").
3. Set the PDE bit in the DMR to enable periodic DMA.

When the timer first expires, the DMA hardware begins the data movement. In this mode, the current descriptor address is automatically saved for later use. When the timer expires the second time, the DMA reloads the saved current descriptor address into the CDAR and restarts. This process continues until an error condition occurs or the timer is stopped.

8.3.3 DMA Operation Flow

Figure 8-2 shows a general flow diagram for the operation of the DMA controller on the MPC8245. Note that for PCI transactions, 64-bit addressing can be implemented with PCI dual address cycles. In this case, upper address registers for descriptors, source, and destinations are used in addition to the registers for 32-bit addressing.

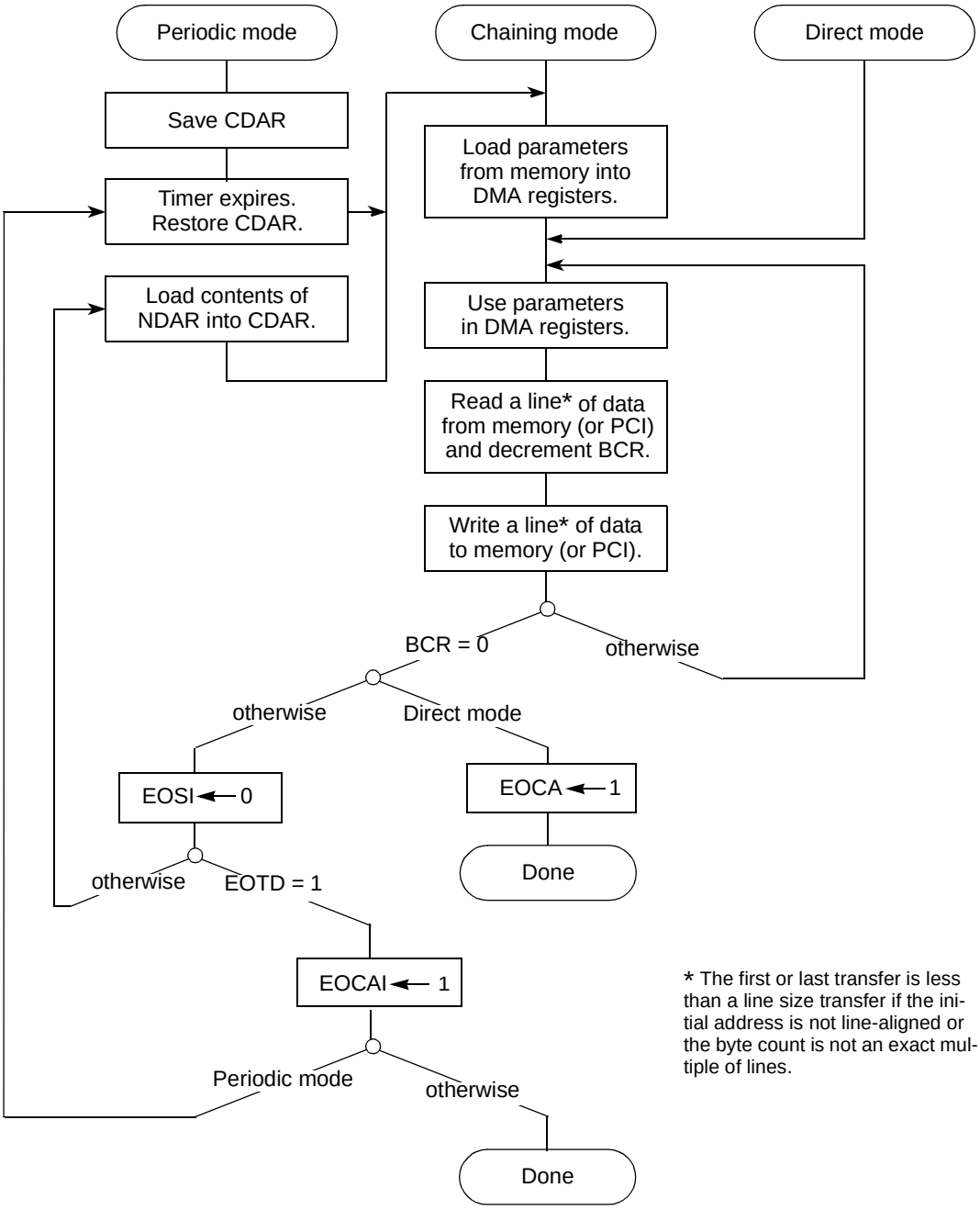


Figure 8-2. DMA Controller General Flow

8.3.4 DMA Coherency

Each DMA channel contains a 64-byte transfer queue. No address snooping occurs in these queues. Certain data could be posted in these queues and be invisible to the rest of the system while a DMA transfer is in progress. Therefore, software must enforce coherency of the transferred region during the DMA process.

Snooping of the processor data cache is selectable during DMA transactions. Because a snoop bit (SNEN) is provided in both the CDAR and the next descriptor address register (NDAR), software can control whether the processor cache is snooped. This bit is described in Section 8.7.3, “Current Descriptor Address Registers (CDARs),” and Section 8.7.10, “Next Descriptor Address Registers (NDARs),” respectively.

NOTE

Enabling snooping of the processor results in slower performance in the DMA channels.

The MPC8245 architecture assumes that all of the local or host memory is prefetchable, including Port X. Multiple reads occur to the same location on the memory interface and Port X.

8.3.5 DMA Performance

The arbitration logic between the DMA controller and other PCI masters is clocked by the PCI clock. However, the DMA controller operates on the memory bus clock, and it communicates to local memory through the central control unit (CCU), which is the memory bus clock also clocks during transactions with the memory controller. This difference in clocking introduces time delays between the time domains of the PCI devices and CCU. The phase of the PCI clock relative to the memory bus clock causes latency between the time the DMA controller is programmed to start a transaction and the time the data is actually returned.

Additionally, take care when polling the DMA registers. Access to any of the system registers (configuration and run-time) on the MPC8245 temporarily interrupts a DMA stream. Thus, if the processor polls the DSR[CB] bit while a DMA transfer is in progress, the DMA transfer is temporarily interrupted and the performance of the DMA transfer is drastically reduced. To obtain the best performance, use the interrupt features of the DMA controller for signaling conditions such as 'channel complete to the processor'.

DMA accesses to local memory may require cache coherency with the processor. Such accesses require snooping on the peripheral logic bus. However, snoop hits from the peripheral logic bus (from a cache) for DMA accesses degrade DMA performance. To minimize this effect, the corresponding areas of memory in the processor caches should be flushed before initiating the DMA transfers. The arbitration priorities described in

Section 13.2, “Internal Arbitration,” show the effect of snooping on the priorities for access to the processor or memory data bus.

Another factor that can affect DMA performance is access to the PCI bus. For more information about the DMA arbitration boundaries for the PCI bus, see Section 7.2.1, “Internal Arbitration for PCI Bus Access.”

8.4 DMA Transfer Types

The DMA controller supports the following four types of transfer

- PCI-to-PCI
- PCI- to-memory
- Memory-to-PCI
- Memory-to-memory

All data is temporarily stored in a 64-byte DMA queue before transmission.

8.4.1 PCI-to-PCI

For PCI-to-PCI memory transfers, the DMA controller begins by reading data from PCI memory space and storing it in the DMA queue. When the source and destination addresses are aligned, the DMA transfer occurs after 64 bytes of data have been stored in the queue. When the source and destination addresses are misaligned, the DMA transfer occurs after 32 bytes of data are stored in the queue. For the last transfer, data in the queue can be less than 32 bytes. The DMA controller begins writing data to PCI memory space, beginning at the destination address. The process is repeated until no more data remains to transfer, or an error condition occurred on the PCI bus.

8.4.2 PCI-to-Local Memory

For PCI-to-local memory transfers, the DMA controller initiates reads on the PCI bus and stores the data in the DMA queue. When at least 32 bytes of data are in the queue, a local memory write is initiated. The DMA controller stops the transferring process either when an error condition occurs on the PCI bus or local memory interface, or no data remains to transfer. Reading from PCI memory and writing to local memory can occur concurrently.

8.4.3 Local Memory-to-PCI

For local memory-to-PCI memory transfers, the DMA controller initially fetches data from local memory into the DMA queue. When the first data arrives into the queue, the DMA engine initiates write transactions to PCI memory. The DMA controller stops the transferring process either when an error occurs on the PCI bus or local memory interface,

or when no data remains to transfer. Reading from local memory and writing to PCI memory can occur concurrently.

8.4.4 Local Memory to Local Memory

For local memory to local memory transfers, the DMA controller begins reading data from local memory and stores it in the DMA queue. When the source and destination addresses are aligned, the DMA transfer occurs after 64 bytes of data are stored in the queue. When the source and destination addresses are misaligned, the DMA transfer occurs after 32 bytes of data are stored in the queue. For the last transfer, data in the queue can be less than 32 bytes. The DMA controller begins writing data to local memory space beginning at the destination address. The process is repeated until no more data remains to transfer or an error condition occurs while accessing memory.

8.5 Address Map Interactions

Because of the flexibility of the DMA controller, certain interactions can occur related to the specific address map and mode where the MPC8245 is operating. Refer to Chapter 14, “Error Handling,” for information about the reporting of these error conditions.

8.5.1 Attempted Writes to Local ROM/Port X Space

If the MPC8245 is in either host or agent mode, CDAR[CCT] indicates that the transferred address is for local memory, and the address falls between 0x7000_0000 and 0x7FFF_FFFF (extended ROM space) and extended ROM is enabled, or 0xFF00_0000 and 0xFFFF_FFFF, only read operations are allowed. Attempts to program the DMA controller to write to this space (comprising the extended ROM space and local ROM/Port X space) under these conditions results in a Flash write error. DSR[LME] is set if ErrDR1[5] is set before the DMA unit completes transferring the data. For a DMA transfer with a small byte count (less than a cache line), the DMA posted write to the CCU buffer can complete before the start of the actual write to local memory. Additionally, this error condition causes the assertion of the internal $\overline{mcp}$ signal and a machine check exception (if enabled).

If extended ROM is not enabled and the address falls between 0x7000_0000 and 0x7FFF_FFFF and no SDRAM is mapped to this address range, all DMA transactions (read and write) result in the assertion of an internal $\overline{mcp}$ and a machine check exception (if enabled and if DMR[LME] is set). See Chapter 14, “Error Handling,” for more information about the internal $\overline{mcp}$ signal.

8.5.2 Host Mode Interactions

The following sections describe cases of interactions with the host mode address maps.

8.5.2.1 PCI Master Abort When PCI Bus Specified for Lower 2-Gbyte Space

If the MPC8245 is in host mode and a transferred address falls within the lower 2-Gbyte space (0x0000_0000 to 0x7FFF_FFFF) on the PCI bus (specified by CDAR[CTT]), the MPC8245 issues the transaction to the PCI bus with that address. However, this address space is reserved for the host controller. No PCI target responds to the transaction, and the transaction terminates with a PCI master abort and the PE bit in DMR is set.

8.5.2.2 Address Alias to Lower 2-Gbyte Space

If the MPC8245 is in host mode, the CDAR[CTT] indicates that the transferred address is for local memory and the address falls between 0x8000_0000 and 0xFEFF_FFFF, the transaction is issued to local memory and the address is aliased to the lower 2-Gbyte space.

8.5.2.3 Attempted Reads From ROM on the PCI Bus—Host Mode

If the MPC8245 is in host mode, CDAR[CTT] indicates that the transferred address is for local ROM space and the MPC8245 is configured for ROM on the PCI bus, the transaction is performed to the local ROM interface. Unknown data is returned. This action is considered a programming error.

8.5.2.4 Attempted Reads From ROM on the Memory Bus

If the MPC8245 is in host mode, the CDAR[CTT] indicates that the transferred address is for PCI ROM space and the MPC8245 is configured for ROM on the local memory interface, the transaction is issued to the PCI bus. The transaction causes either a master abort (and DSR[PE] is set) or an access to a configured device in the ROM address space on the PCI bus.

8.5.2.5 Address Translations for PCI Transactions

If the MPC8245 is in host mode, the ATU is enabled and the CDAR[CTT] indicates that the transferred address is for PCI space, all 32-bit PCI transfer addresses that fall within the outbound translation window are translated through the ATU. No translation occurs if the transferred address is 64 bits. All 32-bit PCI addresses should fall between 0x8000_0000 and 0xFFFF_FFFF because the lower two Gbytes of space belongs to MPC8245.

8.5.3 Agent Mode Interactions

The following sections describe interactions with the agent mode address maps.

8.5.3.1 Agent Mode DMA Transfers for PCI

When CDAR[CTT] indicates that the transferred address is for PCI, any address can be issued within the 32-bit or 64-bit address space. If the software running on an MPC8245 configured as an agent is aware of the system address map, it can perform DMA transfers with the untranslated system address.

Alternatively, the MPC8245 agent DMA driver does not need to be aware of the system memory map, and can rely on address translation that the ATU performs. In this case, transaction addresses should be programmed to fall within the outbound memory window. No translation occurs if the transferred address is 64-bit.

8.5.3.2 Accesses to Outbound Memory Window that Overlaps 0xFE00_0000 – 0xFEEF_FFFF

For agent mode, if the outbound memory window is programmed to overlap the PCI I/O space (0xFE0x_xxxx – 0xFEBx_xxxx), PCI configuration space (0xFECx_xxxx – 0xFEDx_xxxx), or PCI interrupt acknowledge space (0xFEEx_xxxx), a DMA transaction to these address spaces results in a translated outbound address. Note that this operation differs from a processor-generated transaction. In the case of a processor-generated transaction to these spaces, these address ranges appear as holes in the outbound translation window.

8.5.3.3 Attempted Accesses to Local ROM When ROM is on PCI

If the CDAR[CTT] indicates that the transferred address is for local ROM space and the ROM is located on PCI, the transaction is issued to local memory and causes return of unknown data.

8.5.3.4 Attempted Access to ROM on the PCI Bus—Agent Mode

If the CDAR[CTT] indicates that the transferred address is for ROM on the PCI bus and the ROM is located locally, the transaction is issued to the PCI bus and results in a master abort (and DSR[PE] is set) or a completed transaction, depending on whether a device is configured on the PCI bus in that address space.

8.6 DMA Descriptors for Chaining Mode

For DMA chaining mode, DMA descriptors are constructed in either local or PCI memory and linked together by the next descriptor field. The descriptor contains information for the DMA controller to transfer data. Software must ensure that each segment descriptor is aligned on an eight-word boundary. The last descriptor in memory must have the NDAR[EOTD] bit set in the next descriptor field, indicating that this descriptor is the last in memory.

Software initializes the CDAR to point to the first descriptor in memory. The DMA controller traverses through the descriptor chain until the last descriptor is read. For each descriptor in the chain, the DMA controller starts a new DMA transfer with the control parameters that the descriptor specified.

Table 8-2 summarizes the fields of DMA descriptors.

Table 8-2. DMA Descriptor Summary

Descriptor Field	Description
Source address	Contains the source address of the DMA transfer. When the DMA controller reads the descriptor from memory, this field is loaded into the SAR as described in Table 8-4.
High source address	Contains the high source address of the DMA transfer (64-bit PCI source address). When the DMA controller reads the descriptor from memory, this field is loaded into the HSAR.
Destination address	Contains the destination address of the DMA transfer. When the DMA controller reads the descriptor from memory, this field is loaded into the DAR as described in Table 8-4.
High destination address	Contains the high destination address of the DMA transfer (64-bit PCI destination address). When the DMA controller reads the descriptor from memory, this field is loaded into the HDAR.
Next descriptor address	Points to the next descriptor in memory. When the DMA controller reads the descriptor from memory, this field is loaded into the NDAR as described in Table 8-12. If the current descriptor is the last descriptor in memory, the NDAR[EOTD] bit in this descriptor field must be set.
High next descriptor address	Points to the high next descriptor in memory (64-bit PCI descriptor address). When the DMA reads the descriptor from memory, this field is loaded into the HNDAR.
Byte count	Contains the number of bytes to transfer. When the DMA controller reads the descriptor from memory, this field is loaded into the BCR as described in Table 8-11.

Figure 8-3 shows how the DMA descriptors in memory are chained together.

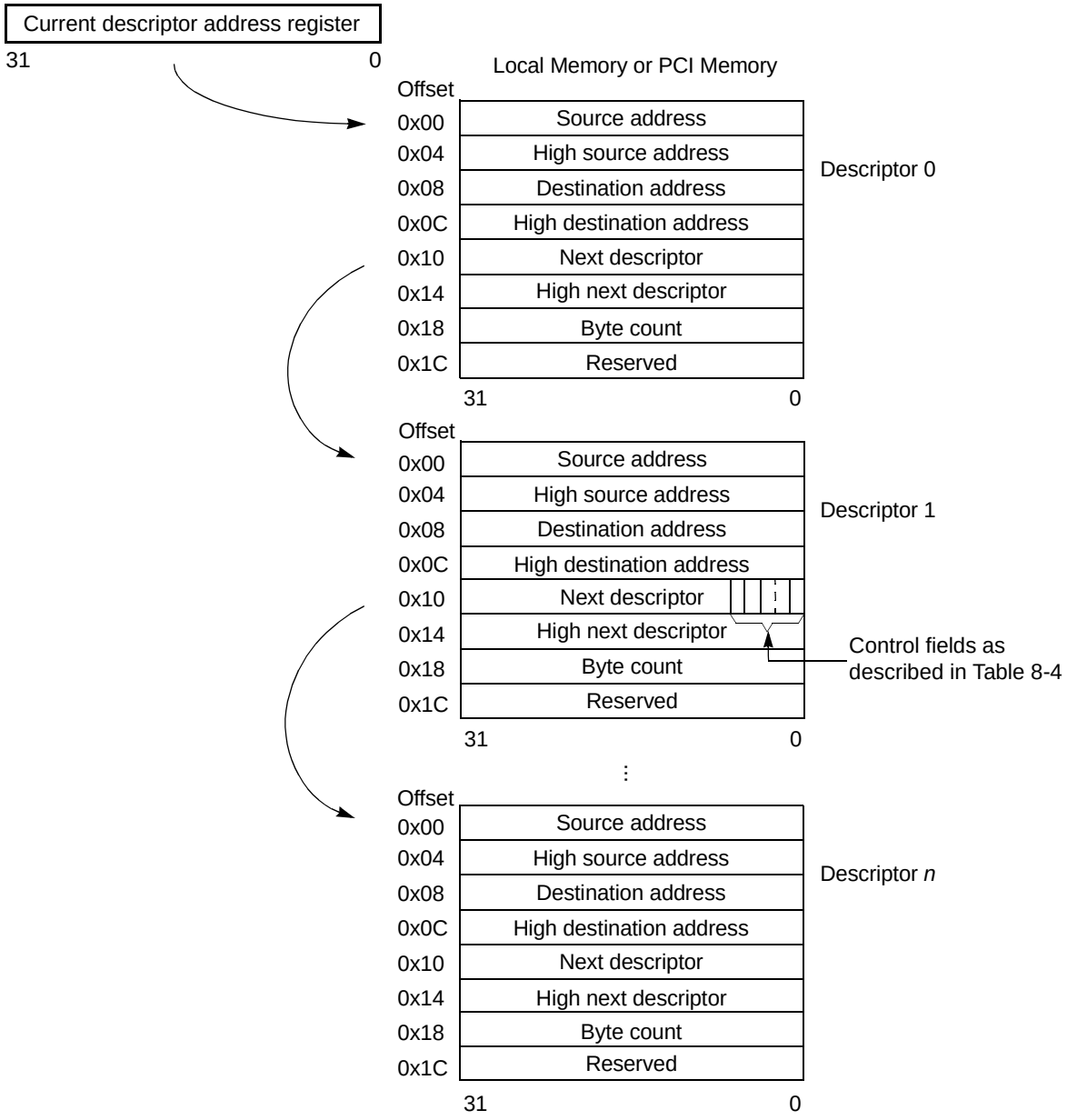


Figure 8-3. Chaining of DMA Descriptors in Memory

8.6.1 Descriptors in Big-Endian Mode

In big-endian byte ordering mode (MSR[LE] = 0 and PICR1[LE_MODE] = 0), the descriptors in local memory should be programmed with data appearing in ascending significant byte order.

For example, a big-endian mode descriptor's data structure is as follows:

```
struct {
        double a;       /* 0x1122334455667788 double word */
        double b;       /* 0x55667788aabbccdd double word */
        double c;       /* 0x8765432101234567 double word */
        double d;       /* 0x0123456789abcdef double word */
} Descriptor;


Results: Source Address = 0x44332211 <MSB..LSB>
        High Source Address = 0x88776655 <MSB..LSB>
        Destination Address = 0x88776655 <MSB..LSB>
        High Destination Address = 0xddccbbaa <MSB..LSB>
        Next Descriptor Address = 0x21436587 <MSB..LSB>
        High Next Descriptor Address = 0x67452301 <M..L>
        Byte Count = 0x67452301 <MSB..LSB>
```

Note that the descriptor `struct` must be aligned on an eight-word (32-byte) boundary.

8.6.2 Descriptors in Little-Endian Mode

In little-endian byte ordering mode (MSR[LE] = 1 and PICR1[LE_MODE] = 1), the descriptor in local memory should be programmed with data appearing in descending significant byte order.

For example, a little-endian mode descriptor's data structure is as follows:

```
struct {
        double a;       /* 0x8877665544332211 double word */
        double b;       /* 0x1122334488776655 double word */
        double c;       /* 0x7654321012345678 double word */
        double d;       /* 0x0123456776543210 double word */
} Descriptor;


Results: Source Address = 0x44332211 <MSB..LSB>
        High Source Address = 0x88776655 <MSB..LSB>
        Destination Address = 0x88776655 <MSB..LSB>
```

```
High Destination Address = 0x11223344 <MSB..LSB>
Next Descriptor Address = 0x12345678 <MSB..LSB>
High Next Descriptor Address = 0x76543210 <M..L>
Byte Count = 0x76543210 <MSB..LSB>
```

Note that the descriptor `struct` must be aligned on an eight-word (32-byte) boundary.

8.7 DMA Register Descriptions

The following sections describe the DMA controller registers and their bit settings in detail. Note that the PCI address offset is listed as part of the register description table titles. For the local memory offsets, see Table 8-1.

8.7.1 DMA Mode Registers (DMRs)

The DMRs allow software to start the DMA transfer and to control various DMA transfer characteristics. Figure 8-4 shows the bits in the DMR.

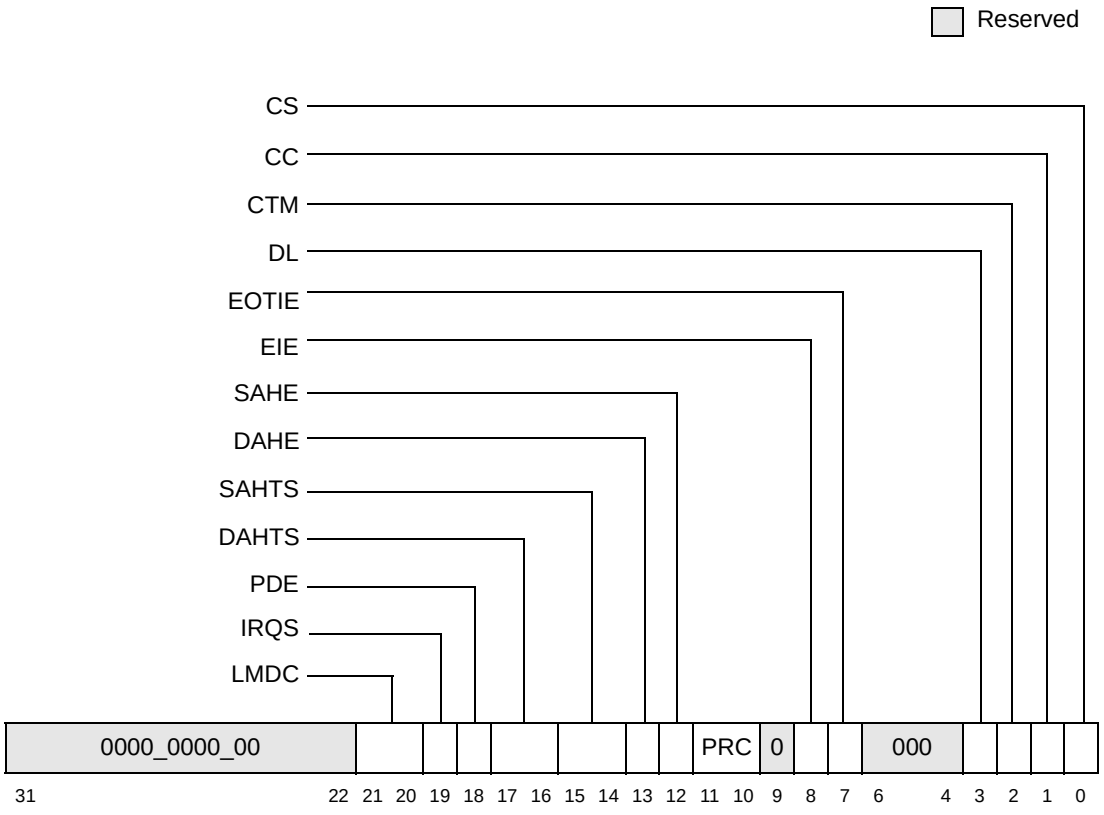


Figure 8-4. DMA Mode Register (DMR)

Table 8-3 describes the bit settings for the DMR.

Table 8-3. DMR Field Descriptions—Offsets 0x100, 0x200

Bits	Name	Reset Value	R/W	Description
31–22	—	0	R	Reserved
21–20	LMDC	00	R/W	Local memory delay count. This field controls the delay between the DMA transfer of each cache line (32 bytes) access to local memory. The delay value is the time from the last successful DMA transfer until the next request occurs to local memory. Increasing this value to something greater than 0b00 gives a greater probability of PCI accesses gaining arbitration to the shared processor/memory bus while a DMA transfer is in progress. Refer to Section 13.2.1, “Arbitration Between PCI and DMA Accesses to Local Memory,” for more information. 00 2 *sys_logic_clk* cycles for PCI to memory clock ratios of 1:1, 2:1 and 3:2; 4 *sys_logic_clk* cycles for other ratios 01 4 *sys_logic_clk* cycles 10 16 *sys_logic_clk* cycles 11 32 *sys_logic_clk* cycles
19	IRQS	0	R/W	Interrupt steer 0 Routes all DMA interrupts to the processor core through the internal $\overline{int}$ mechanism and the PIC unit. 1 Routes all DMA interrupts to the PCI bus through the external $\overline{\text{INTA}}$ signal.
18	PDE	0	R/W	Periodic DMA enable. Applies only to chaining mode. Otherwise, it is ignored. Refer to Section 8.3.2.2, “Periodic DMA Feature,” for more information. 0 Disables periodic DMA restart. 1 Allows hardware to periodically restart the DMA process. DMR[CS] should be set when this bit is set.
17–16	DAHTS	00	R/W	Destination address hold transfer size. Applies only to direct mode (not used in chaining mode). Indicates the transfer size used for each transaction when the DAHE bit is set. The BCR value must be in multiples of this size and the DAR value must be aligned based on this size. 00 1 byte 01 2 bytes 10 4 bytes 11 8 bytes
15–14	SAHTS	00	R/W	Source address hold transfer size. Applies only to direct mode (not used in chaining mode). Indicates the transfer size used for each transaction when the SAHE bit is set. The BCR value must be in multiples of this size and the SAR value must be aligned based on this size. 00 1 byte 01 2 bytes 10 4 bytes 11 8 bytes
13	DAHE	0	R/W	Destination address hold enable (direct mode only). Applies only to direct mode (not used in chaining mode). Allows the DMA controller to hold the destination address to a fixed value for every transfer. The size used for the transfers is indicated by DAHTS. The MPC8245 supports only aligned transfers for this feature. Only one of DAHE or SAHE may be set at one time. 0 Disables the destination address hold feature. 1 Enables the destination address hold feature.

Table 8-3. DMR Field Descriptions—Offsets 0x100, 0x200 (continued)

Bits	Name	Reset Value	R/W	Description
12	SAHE	0	R/W	Source address hold enable (direct mode only). Applies only to direct mode (not used in chaining mode). Allows the DMA controller to hold the source address to a fixed value for every transfer. The size used for the transfers is indicated by SAHTS. The MPC8245 supports only aligned transfers for this feature. Only one of DAHE or SAHE may be set at one time. 0 Disables the source address hold feature. 1 Enables the source address hold feature.
11–10	PRC	00	R/W	PCI Read Command. Indicates the types of PCI read command to be used. 00 PCI Read 01 PCI Read-line 10 PCI Read-multiple 11 Reserved
9	—	0	R	Reserved
8	EIE	0	R/W	Error interrupt enable. Interrupt mechanism used depends on the setting of the IRQS bit. 0 Disables error interrupts. 1 Generates an interrupt to the processor core, through the internal $\overline{int}$ mechanism and the PIC unit, if a memory or PCI error occurs during a DMA transfer (signaled by the setting of LME or PE in the DSR).
7	EOTIE	0	R/W	End-of-transfer interrupt enable. Interrupt mechanism used depends on the setting of the IRQS bit. 0 Disables end-of-transfer interrupts. 1 Generates an interrupt at the completion of a DMA transfer (that is, NDAR[EOTD] bit is set). For chained DMA, the interrupt is driven active at the end of the last segment. For periodic DMA, the interrupt is driven at the end of each periodic transfer event.
6–4	—	000	R	Reserved
3	DL	0	R/W	Descriptor location 0 The descriptor is located in the local memory space. 1 The descriptor is located in the PCI memory space.
2	CTM	0	R/W	Channel transfer mode 0 Chaining mode. See Section 8.3.2, “DMA Chaining Mode.” 1 Direct DMA mode. Software is responsible for placing all the required parameters into the necessary registers to start the DMA process. See Section 8.3.1, “DMA Direct Mode.”

Table 8-3. DMR Field Descriptions—Offsets 0x100, 0x200 (continued)

Bits	Name	Reset Value	R/W	Description
1	CC	0	R/W	Channel continue. This bit applies only to chaining mode and is cleared by the MPC8245 after every descriptor read. It operates independently of DMR[CS]. It is typically set after software dynamically adds more descriptors to a chain that is currently in progress or to a finished chain. Note that it is not advisable to remove descriptors by setting this bit because there is no deterministic way to predict when the DMA controller reads a specific descriptor. 0 Channel stopped 1 The DMA transfer restarts the transferring process starting at the current descriptor address (in CDAR).
0	CS	0	R/W	Channel start. This bit is toggled by software. A 0 to 1 transition when the channel is not busy (DSR[CB] = 0) starts the DMA process. If the channel is busy and a 0 to 1 transition occurs, the DMA channel restarts from a previous halt condition. A 1 to 0 transition when the channel is busy (DSR[CB] = 1) halts the DMA process. Note that in chaining mode, it is not necessary to halt the channel to modify a descriptor because descriptors can be modified by setting the DMR[CC] bit. Nothing happens if the channel is not busy and a 1 to 0 transition occurs.

The values in the PRC field are used as follows:

- If PRC = 00 (PCI read), all DMA reads from PCI use the PCI read command.
- If PRC = 01 (PCI read line), the PCI read line command is used if the PCLSR is programmed for 32-byte cache lines, and the current DMA transfer is for at least two 32-bit transactions. Otherwise, PCI read commands are used. See Section 4.2.5, “PCI Cache Line Size—Offset 0x0C.”
- If PRC = 10 (PCI read multiple), the PCI read multiple command is used if the PCLSR is programmed for 32-byte cache lines, the current DMA transfer is aligned on a cache line address, and more than one full cache line of data is to be transferred. Otherwise, if the current DMA transfer is for at least two 32-bit transactions (and less than or equal to one cache line), the read line command is used. If the conditions for using the PCI read line command above are not met, the PCI read command is used.

8.7.2 DMA Status Registers (DSRs)

The DSRs report various DMA conditions during and after the DMA transfer. Writing a 1 to a set bit clears the bit. Software attempting to determine the source of interrupts should always perform a logical AND function between the bits of the DSR and their corresponding enable bits in the DMR and CDAR.

Figure 8-5 shows the bits in the DSR.

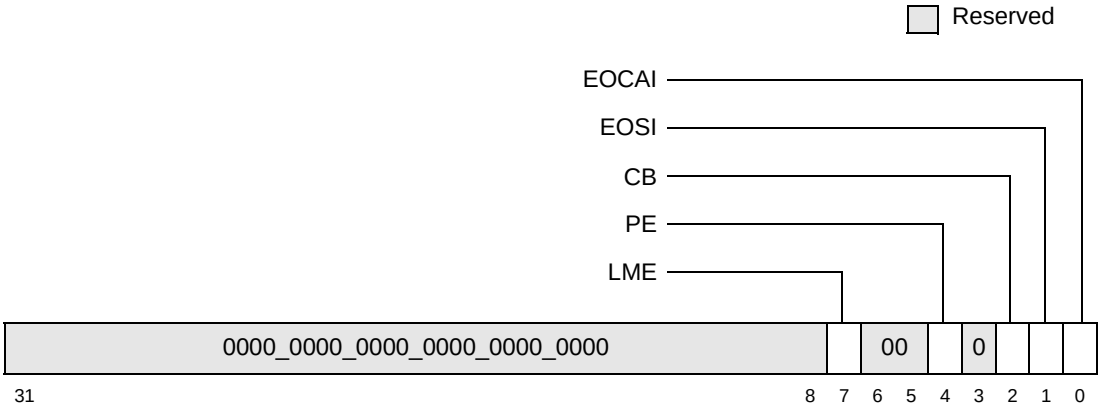


Figure 8-5. DMA Status Register (DSR)

Table 8-4 describes the bit settings for the DSR.

Table 8-4. DSR Field Descriptions—Offsets 0x104, 0x204

Bits	Name	Reset Value	R/W	Description
31–8	—	All 0s	R	Reserved
7	LME	0	R/W Write1 clears	Local memory error 0 No local memory error. When this bit is set, it can be cleared only by writing a 1 to it or by a hard reset. 1 A memory error condition occurred during the DMA transfer. This bit mirrors the ErrDR1bits 2, 3, 5, and 6 (see Section 4.8.2, “Error Enabling and Detection Registers”). Software should set the corresponding enable bits in the error enabling register. When an error is detected, software should clear both the LME bit and the bits in the error detection register. If DMR[EIE] = 1, an interrupt is generated.
6–5	—	00	R	Reserved
4	PE	0	R/W Write 1 clears	PCI error 0 No PCI error. When this bit is set, it can be cleared only by writing a 1 to it or by a hard reset. 1 A master or target abort condition or a read parity error occurred on the PCI bus during the DMA transfer. If DMR[EIE] = 1, an interrupt is generated.
3	—	0	R	Reserved
2	CB	0	R	Channel busy 0 Channel not busy. This bit is cleared by the MPC8245 as a result of an error, a hard reset, or when the DMA transfer is finished. 1 A DMA transfer is currently in progress.

Table 8-4. DSR Field Descriptions—Offsets 0x104, 0x204 (continued)

Bits	Name	Reset Value	R/W	Description
1	EOSI	0	R/W Write 1 clears	End-of-segment interrupt 0 No end-of-segment condition. When this bit is set, it can only be cleared by writing a 1 to it or by a hard reset. 1 After the block of data has finished transferring, this bit is set. If CDAR[EOSIE] = 1, an interrupt is generated. Otherwise, no interrupt is generated.
0	EOCAI	0	R/W Write 1 clears	End-of-chain/direct interrupt 0 DMA transfer not finished. When this bit is set, it can only be cleared by writing a 1 to it or by a hard reset. 1 If DMR[EOTIE] = 1 and the last DMA transfer is finished, either in chaining or direct mode, this bit is set and an interrupt is generated.

8.7.3 Current Descriptor Address Registers (CDARs)

The CDARs contain the current address of the descriptor in memory to be loaded, one for each DMA channel. In chaining mode, software must initialize this register to point to the first descriptor in memory. When the DMR[CS] is set, the DMA controller begins fetching the first descriptor pointed to by the CDAR. After the descriptor is fetched from memory, the source address register (SAR), destination address register (DAR), next descriptor address register (NDAR), and byte count register (BCR) are updated with the appropriate information provided by the descriptor loaded from memory. See Section 8.6, “DMA Descriptors for Chaining Mode,” for more information. The DMA engine is now ready to move data.

After transferring data defined by the first descriptor, if the NDAR[EOTD] bit is not set, the DMA controller loads the contents of the NDAR into the CDAR and begins transferring data based on the next descriptor in memory. Note that at this point, the content of the CDAR and NDAR are the same. The fetching of descriptors and data transfer continues until the DMA engine encounters an error or the descriptor is the last in memory (NDAR[EOTD] = 1). If the NDAR[EOTD] = 1, the DMA transfer is finished. The SNEN, EOSIE, and CTT bits are used in both chaining and direct modes. If the descriptor is located in PCI space (DMR[DL] = 1) and the CDA is within the outbound translation window, the CDA is translated. See Section 3.3.2, “Outbound PCI Address Translation,” for more information.

Figure 8-6 shows the bits in the CDAR, and Table 8-5 describes the bit settings for the CDAR.

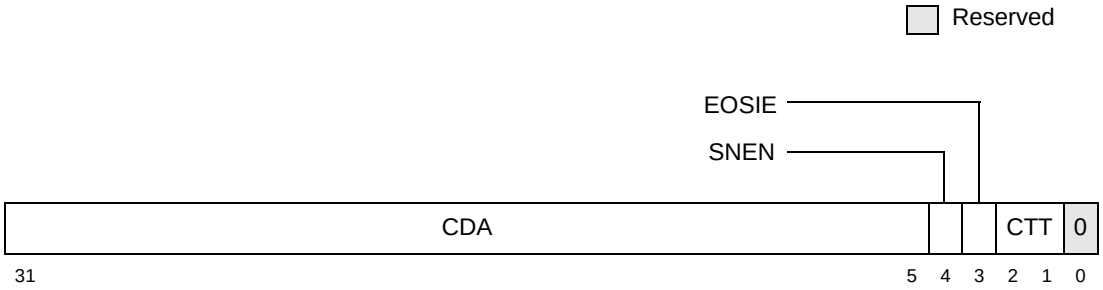


Figure 8-6. Current Descriptor Address Register (CDAR)

Table 8-5. CDAR Field Descriptions—Offsets 0x108, 0x208

Bits	Name	Reset Value	R/W	Description
31–5	CDA	All 0s	R/W	Current descriptor address. Contains the current descriptor address of the buffer descriptor in memory. It must be aligned on an eight-word boundary. These bits are valid only for chaining mode.
4	SNEN	0	R/W	Snoop enable. When set, enables snooping of the local processor during DMA transactions. The transaction can be a descriptor fetch or local memory read/write. This bit is valid for both chaining and direct modes. In chaining mode, each descriptor has individually controlled snooping characteristics. 0 Disables snooping. 1 Enables processor core snooping for DMA transactions if PICR[NO_SNOOP_EN] = 0. If PICR[NO_SNOOP_EN] = 1, snooping is disabled.
3	EOSIE	0	R/W	End-of-segment interrupt enable. Interrupt mechanism used depends on the setting of DMR[IRQS]. This bit is valid only for chaining mode. 0 End-of-segment interrupt disabled. 1 Generates an interrupt if the DMA transfer for the current descriptor is finished.
2–1	CTT	00	R/W	Channel transfer type. These two bits specify the type/direction of the DMA transfer. These bits are valid for both chaining and direct modes. 00 Local memory-to-local memory transfer 01 Local memory-to-PCI transfer 10 PCI-to-local memory transfer 11 PCI-to-PCI transfer
0	—	0	R	Reserved

8.7.4 High Current Descriptor Address Registers (HCDARs)

The HCDARs contain the upper 32-bit current address of the descriptor in PCI memory to be loaded. This register is valid only if DMR[DL] is set, indicating that the descriptor is located in PCI space. If an HCDAR is set to a non-zero value and the descriptor is located in PCI space, a DAC fetches the descriptor and the transaction always misses the outbound

translation window. If this register is cleared, a single address cycle (SAC) is generated and the address translation is determined by CDAR. See Section 8.7.3, “Current Descriptor Address Registers (CDARs),” for more information.

Figure 8-7 shows the bits in the HCDAR.

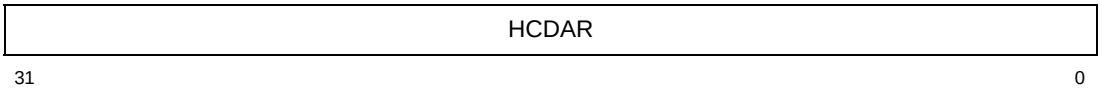


Figure 8-7. High Current Descriptor Address Register (HCDAR)

Table 8-6 describes the bit settings for the HCDAR.

Table 8-6. HCDAR Field Description—Offsets 0x10C, 0x20C

Bits	Name	Reset Value	R/W	Description
31–0	HCDAR	All 0s	R/W	High current descriptor address. This register contains the upper 32-bit address of the current descriptor to be loaded when a descriptor is located in PCI space. When this register is non-zero, 64-bit addressing and DACs fetch descriptors.

8.7.5 Source Address Registers (SARs)

The SARs indicate the address where the DMA controller reads data. This address can be either a PCI memory or local memory address. The software must ensure that this memory address is valid. All DMA to PCI read transactions are translated if the SAR address is within the outbound translation window. See Section 3.3.2, “Outbound PCI Address Translation,” for more information.

Figure 8-8 shows the bits in the SAR.

Figure 8-8. Source Address Register (SAR)

Table 8-7 describes the bit settings for the SAR.

Table 8-7. SAR Field Description—Offsets 0x110, 0x210

Bits	Name	Reset Value	R/W	Description
31–0	SAR	All 0s	R/W	Source address. This register contains the source address of the DMA transfer. The MPC8245 updates the content after every DMA read operation.

8.7.6 High Source Address Registers (HSARs)

The HSARs indicate the upper 32-bits of address where the DMA controller reads data for PCI accesses addressed with 64-bits. These high-order 32 bits of address are valid only when reading from the PCI bus (that is, PCI to local memory or PCI-to-PCI transfer). If this register is set to a non-zero value and the source data is located in PCI space, a DAC fetches the data, and the transaction always misses the outbound translation window. If this register is cleared, a SAC is generated and SAR determines the address translation. See Section 8.7.5, “Source Address Registers (SARs),” for more information.

Figure 8-9 shows the bits in the HSAR.

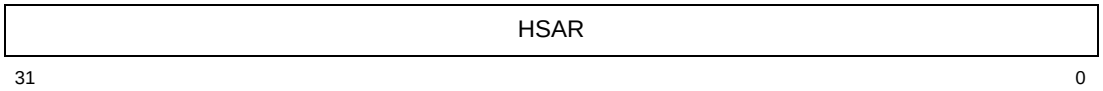


Figure 8-9. High Source Address Register (HSAR)

Table 8-8 describes the bit settings for the HSAR.

Table 8-8. HSAR Field Description—Offsets 0x114, 0x214

Bits	Name	Reset Value	R/W	Description
31–0	HSAR	All 0s	R/W	High source address. This register contains the upper 32-bit source address of a DMA transfer from PCI. When this register is non-zero, 64-bit addressing and DACs are used to fetch source data.

8.7.7 Destination Address Registers (DARs)

The DARs indicate the address where the DMA controller writes data. This address can be either a PCI memory or local memory address. The software has to ensure that this is a valid memory address. All DMA-to-PCI write transactions are translated if the DAR address is within the outbound translation window. See Section 3.3.2, “Outbound PCI Address Translation,” for more information.

Figure 8-10 shows the bits in the SARs.

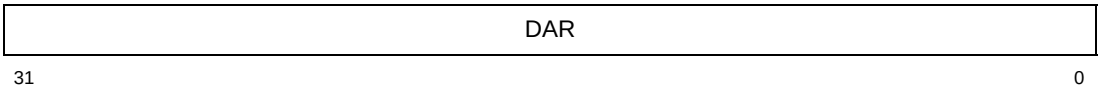


Figure 8-10. Destination Address Register (DAR)

Table 8-9 describes the bit settings for the DAR.

Table 8-9. DAR Field Description—Offsets 0x118, 0x218

Bits	Name	Reset Value	R/W	Description
31–0	DAR	All 0s	R/W	Destination address. This register contains the destination address of the DMA transfer. The content is updated by the MPC8245 after every DMA write operation.

8.7.8 High Destination Address Registers (HDARs)

The HDARs contain the upper 32-bits of address where the DMA controller writes data for PCI accesses addressed with 64 bits. These high-order 32 bits of address are valid only when reading from the PCI bus (that is, PCI-to Local Memory or PCI-to-PCI transfer). If this register is set to a non-zero value and the destination data is located in PCI space, a DAC is used to fetch the data, and the transaction always misses the outbound translation window. If this register is cleared, a SAC is generated and the address translation is determined by DAR. See Section 8.7.7, “Destination Address Registers (DARs),” for more information.

Figure 8-11 shows the bits in the HDARs.

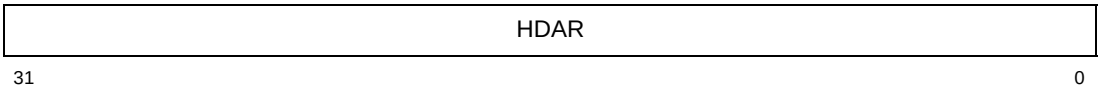


Figure 8-11. High Destination Address Register (HDAR)

Table 8-10 describes the bit settings for the HDARs.

Table 8-10. HDAR Field Description—Offsets 0x11C, 0x21C

Bits	Name	Reset Value	R/W	Description
31–0	HDAR	All 0s	R/W	High destination address. This register contains the upper 32-bit destination address of a DMA transfer from PCI. When this register is non-zero, 64-bit addressing and DACs are used to fetch destination data.

8.7.9 Byte Count Registers (BCRs)

The BCRs contain the number of bytes per transfer. The maximum transfer size is 64 Mbytes minus one byte.

Figure 8-12 shows the bits in the BCR.

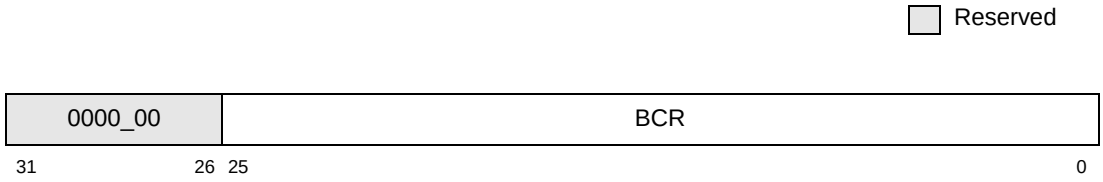


Figure 8-12. Byte Count Register (BCR)

Table 8-11 describes the bit settings for the BCR.

Table 8-11. BCR Field Descriptions—Offsets 0x120, 0x220

Bits	Name	Reset Value	R/W	Description
31–26	—	All 0s	R/W	Reserved
25–0	BCR	All 0s	R/W	Byte count. Contains the number of bytes to transfer. The value in this register is automatically decremented by the MPC8245 after each DMA read operation until BCR = 0.

8.7.10 Next Descriptor Address Registers (NDARs)

The NDARs contain the address for the next descriptor in memory. Software is not expected to initialize this register. This register contains valid information only after the DMA engine has fetched a descriptor to which the CDAR pointed. All data bits, with the exception of EOTD, belong to the next descriptor to be loaded and executed. When the data bits are transferred to the CDAR, the bits become effective for the current transfer.

Figure 8-13 shows the bits in the NDAR.

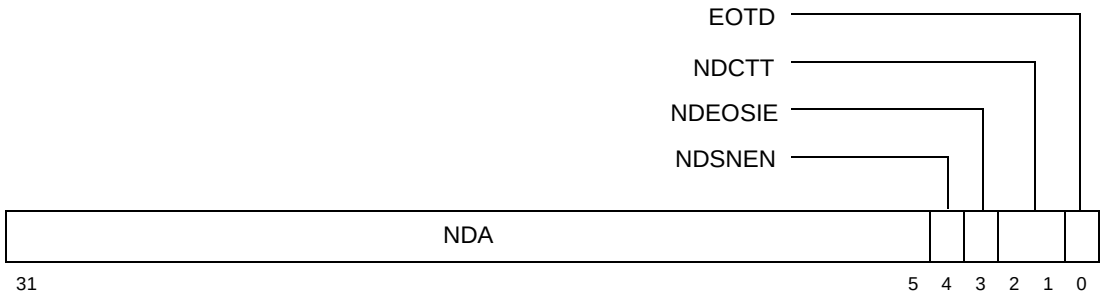


Figure 8-13. Next Descriptor Address Register (NDAR)

Table 8-12 describes the bit settings for the NDAR.

Table 8-12. NDAR Field Descriptions—Offsets 0x124, 0x224

Bits	Name	Reset Value	R/W	Description
31–5	NDA	All 0s	R/W	Next descriptor address. Contains the next descriptor address of the buffer descriptor in memory; must be aligned on an 8-word boundary.
4	NDSNEN	0	R/W	Next descriptor snoop enable. This bit is valid for both chaining and direct modes. 0 Disables snooping 1 Enables processor core snooping for DMA transactions
3	NDEOSIE	0	R/W	Next descriptor end-of-segment interrupt enable. Interrupt mechanism used depends on the setting of DMR[IRQS]. This bit is valid only for chaining mode. 0 End-of-segment interrupt disabled 1 Generates an interrupt if the DMA transfer for the next descriptor is finished
2–1	NDCTT	00	R/W	Next descriptor channel transfer type. These two bits specify the type/direction of the DMA transfer. These bits are valid for both chaining and direct modes. 00 Local memory to local memory transfer 01 Local memory to PCI transfer 10 PCI to local memory transfer 11 PCI to PCI transfer
0	EOTD	0	R/W	End-of-transfer descriptor. This bit is ignored in direct mode. 0 This descriptor is not the last descriptor in memory 1 Indicates that this descriptor is the last descriptor in memory. If this bit is set, NDAR bits 4, 3, 2, and 1 are ignored and the DMA controller finishes after the current buffer transaction is finished.

8.7.11 High Next Descriptor Address Registers (HNDARs)

The HNARs contain the upper 32-bits of address for the next descriptor in PCI space. Software is not expected to initialize this register. This register contains valid information only after the DMA engine has fetched a descriptor to which the CDAR pointed.

Figure 8-14 shows the bits in the HNDAR.

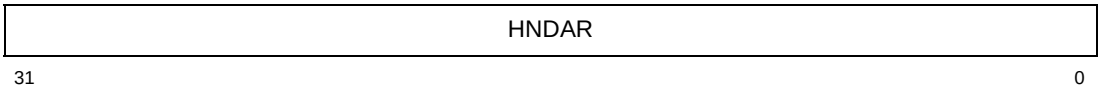


Figure 8-14. High Next Descriptor Address Register (HNDAR)

Table 8-13 describes the bit settings for the HNDAR.

Table 8-13. HNDAR Field Description—Offsets 0x128, 0x228

Bits	Name	Reset Value	R/W	Description
31–0	HNDAR	All 0s	R/W	High next descriptor address. This register contains the upper 32-bit address of the next descriptor to be loaded. Only valid if the descriptor is in PCI space

Chapter 9
Message Unit (with I_2O)

The MPC8245 provides a message unit (MU) to facilitate communications between the host processor and peripheral processors. The MPC8245's MU can operate with generic messages and doorbell registers; it also implements an I_2O-compliant interface. This chapter describes the interfaces that the MU implements and provides details on registers it uses.

9.1 Message Unit (MU) Overview

An embedded processor is often part of a larger system containing many processors and distributed memory. These processors tend to work on tasks independent of host processors and other peripheral processors in the system. The independent nature of the tasks makes it necessary to provide a communication mechanism between the peripheral processors and the rest of the system. The MU of the MPC8245 provides the following features that can be used for this communication:

- A generic message and doorbell register interface
- An I_2O-compliant interface

The message unit uses the internal $\overline{int}$ and $\overline{\text{INTA}}$ signals to communicate messages to the processor core and the PCI bus. Internal $\overline{int}$ interrupts generated by the I^2C interface, DUART module, DMA unit, or watchpoint events are first routed to the MU. These collected interrupts are then pooled with the doorbell message registers and I_2O interrupts and routed to the PIC unit as MU interrupts before the generation of the internal $\overline{int}$ to the processor. Note that the PIC unit only passes internally generated interrupts to the processor core when pass-through mode is disabled (GCR[M] = 0). See Section 11.4, "PIC Pass-Through Mode," for more information. Conversely, the MU pools the various sources of $\overline{\text{INTA}}$ (from the DMA unit, the DUART unit, watchpoint events, and MU-generated interrupt conditions) for $\overline{\text{INTA}}$ assertion on the PCI bus.

9.2 Message and Doorbell Register Programming Model

The message and doorbell registers are described in the following subsections. Note that the interrupt status and interrupt mask bits for the message and doorbell registers are in the

OMISR, OMIMR, IMISR, and IMIMR I_2O registers. See Section 9.3.4.1, “PCI-Accessible I2O Registers” and Section 9.3.4.2, “Processor-Accessible I2O Registers,” for more information about these registers.

NOTE

OPQIM must be cleared to allow OPQI to generate an interrupt.

The outbound message and doorbell registers communicate with a PCI host by asserting the $\overline{\text{INTA}}$ signal on the PCI bus. The PCI host is the device that handles the PCI interrupts.

The message and doorbell registers can perform peer-to-peer communication among multiple MPC8245 devices in a system. In this scenario, only the inbound registers should be used, and they should be all mapped to different PCSRBAR locations. Because a host is not in this scenario, $\overline{\text{INTA}}$ is not generated and the outbound registers are not used.

9.2.1 Message and Doorbell Register Summary

MPC8245 contains two 32-bit inbound message registers (IMR0 and IMR1) and two 32-bit outbound message registers (OMR0 and OMR1) that function in both host and agent mode.

Table 9-1 summarizes the message registers.

Table 9-1. Message Register Summary

PCI Offset	Local Memory Offset	Acronym	Name
0x050	0x0_0050	IMR0	Inbound message register 0
0x054	0x0_0054	IMR1	Inbound message register 1
0x058	0x0_0058	OMR0	Outbound message register 0
0x05C	0x0_005C	OMR1	Outbound message register 1

9.2.2 Message Register Descriptions

The IMRs allow a remote host or PCI master to write a 32-bit value that automatically generates an interrupt to the processor core through the PIC unit. The OMRs allow the processor core to write an outbound message that automatically causes the outbound interrupt signal $\overline{\text{INTA}}$ to be asserted on the PCI bus. These interrupts can be masked in the IMIMR and OMIMR. When the message registers are written, their corresponding interrupt status bits in the IMISR and OMISR are set.

Figure 9-1 shows the bits of the IMRs and OMRs.

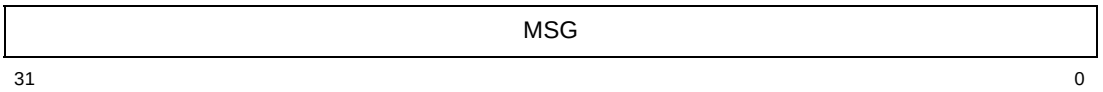


Figure 9-1. Message Registers (IMRs and OMRs)

Table 9-2 shows the bits settings for the IMRs and OMRs.

Table 9-2. IMR and OMR Field Descriptions— Offsets 0x050–0x05C, 0x0_0050–0x0_005C

Bits	Name	Reset Value	R/W	Description
31–0	MSG	Undefined	R/W	The inbound and outbound message registers contain generic message data to be passed between the processor core and remote processors.

9.2.3 Doorbell Register Descriptions

The IDBR allows a remote processor to set a bit in the register from the PCI bus, and in turn generates an interrupt to the processor core through the PIC unit if the interrupt is not masked in IMIMR, or generates $\overline{mcp}$ (if it is not masked in IMIMR). After the local interrupt (or $\overline{mcp}$) is generated, it can only be cleared by the processor core by writing a 1 to the bits that are set in the IDBR. The remote processor can only generate the local interrupt through the IDBR; it cannot clear the interrupt. Figure 9-2 shows the IDBR.

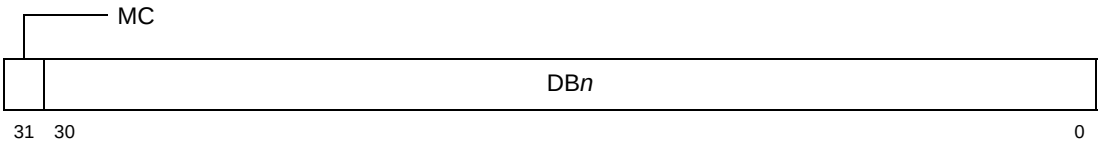


Figure 9-2. Inbound Doorbell Register (IDBR)

Table 9-3 shows the bit settings for the IDBR.

Table 9-3. IDBR Field Descriptions—Offsets 0x068, 0x0_0068

Bits	Name	Reset Value	R/W	Description
31	MC	0	R/W	Machine check 0 No machine check 1 Writing to this bit causes the assertion of $\overline{mcp}$ to the processor core if IMIMR[DMCM] = 0; it also causes IMISR[DMC] to be set. Writing 1 from PCI sets the bit; writing 1 from the processor core clears the bit.
30–0	DB*n*	All 0s	R/W	Inbound doorbell *n* interrupt, where *n* is each bit 0 No inbound doorbell interrupt 1 Setting any bit in this register from the PCI bus causes an interrupt to be generated through the $\overline{int}$ signal to the processor core if IMIMR[IDIM] = 0; it also causes IMISR[IDI] to be set. Writing 1 from PCI sets the bit; writing 1 from the processor core clears the bit.

Alternatively, the MPC8245 processor core can write to the ODBR, which causes the outbound interrupt signal INTA to be asserted, interrupting a remote processor if the interrupt is not masked in OMIMR. When INTA is generated, it can be cleared only by the remote processor (through PCI) by writing a 1 to the bits that are set in the ODBR. The processor core can generate INTA only through the ODBR, and it cannot clear this interrupt.

Figure 9-3 shows the ODBR.

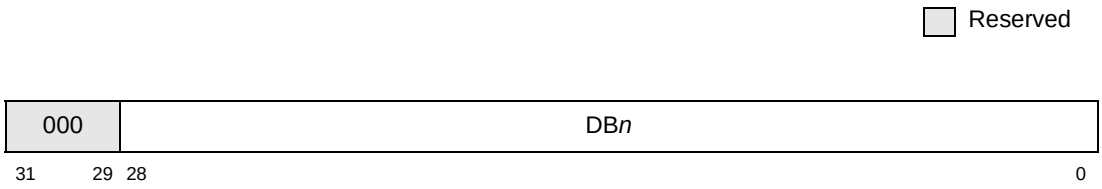


Figure 9-3. Outbound Doorbell Register (ODBR)

Table 9-4 shows the bit settings for the ODBR.

Table 9-4. ODBR Field Descriptions—Offsets 0x060, 0x0_0060

Bits	Name	Reset Value	R/W	Description
31–29	—	000	R	Reserved
28–0	DB*n*	All 0s	R/W	Outbound doorbell interrupt *n* where *n* is each bit. Writing any bit in this register from the processor core causes an external interrupt (INTA) to be signalled if IMIMR[ODIM] = 0; it also causes OMISR[ODI] to be set. Writing 1 from the processor core sets the bit; writing 1 from PCI clears the bit.

9.3 I_2O Interface

The intelligent input output (I_2O) specification was established in the industry to allow architecture-independent I/O subsystems to communicate with an OS through an abstraction layer. The specification is centered around a message-passing scheme. An I_2O-compliant embedded peripheral (IOP) is comprised of memory, processor, and I/O devices. The IOP dedicates a certain space in its local memory to hold messages inbound (from the remote processor) and outbound (to the remote processor). The space is managed as memory-mapped FIFOs with pointers to this memory maintained through the MPC8245 I_2O registers.

9.3.1 PCI Configuration Identification

The I_2O specification defines extensions for the PCI bus through which message queues are managed in hardware. A host identifies an IOP by its PCI class code. Table 9-5 provides the configuration information available to the host when the I_2O unit is enabled.

Table 9-5. I_2O PCI Configuration Identification Register Settings

PCI Configuration Offset	Local Memory Offset	Register	Description
0x09	0x09	PCI CFG	PCI configuration—Programming interface code PCI data returned: 0x01
0x0A	0x0A	PCI CFG	PCI configuration—Sub class PCI data returned: 0x00
0x0B	0x0B	PCI CFG	PCI configuration—PCI base class Data returned: 0x0E

See Section 4.2, “PCI Interface Configuration Registers,” for more information about the PCI base class and programming interface codes. The subclass is described in more detail in the PCI specification.

9.3.2 I_2O Register Summary

The MPC8245 I_2O registers are summarized in Table 9-6.

Table 9-6. I_2O Register Summary

PCI Offset	Local Memory Offset	Register	Name
0x030	—	OMISR	Outbound message interrupt status register
0x034	—	OMIMR	Outbound message interrupt mask register
0x040	—	IFQPR	Inbound FIFO queue port register
0x044	—	OFQPR	Outbound FIFO queue port register
—	0x0_0100	IMISR	Inbound message interrupt status register
—	0x0_0104	IMIMR	Inbound message interrupt mask register
—	0x0_0120	IFHPR	Inbound free_FIFO head pointer register
—	0x0_0128	IFTPR	Inbound free_FIFO tail pointer register
—	0x0_0130	IPHPR	Inbound post_FIFO head pointer register
—	0x0_0138	IPTPR	Inbound post_FIFO tail pointer register
—	0x0_0140	OFHPR	Outbound free_FIFO head pointer register
—	0x0_0148	OFTPR	Outbound free_FIFO tail pointer register
—	0x0_0150	OPHPR	Outbound post_FIFO head pointer register
—	0x0_0158	OPTPR	Outbound post_FIFO tail pointer register
—	0x0_0164	MUCR	Messaging unit control register
—	0x0_0170	QBAR	Queue base address register. Must be set on 1-Mbyte boundary

9.3.3 FIFO Descriptions

Messages have two paths—an inbound queue to receive messages from the remote host (and other IOPs) and an outbound queue to pass messages to a remote host. Each queue is implemented as a pair of FIFOs. The inbound and outbound message queues each consist of a free_list FIFO and a post_list FIFO.

Messages are comprised of frames that are at least 64 bytes long. The message frame address (MFA) points to the first byte of the message frame. The messages are located in a pool of system memory (any memory address accessible through the PCI bus). Four FIFOs that are located in local memory track the status and location of these messages. One FIFO in each queue tracks the free MFAs (free_list FIFO). The other FIFO tracks the MFAs that have posted messages (post_list FIFO). These FIFOs are managed by the remote processors and the processor core through the MPC8245 I_2O registers. For more information, see Section 9.3.2, “I2O Register Summary.”

Figure 9-4 shows an example of the message queues:

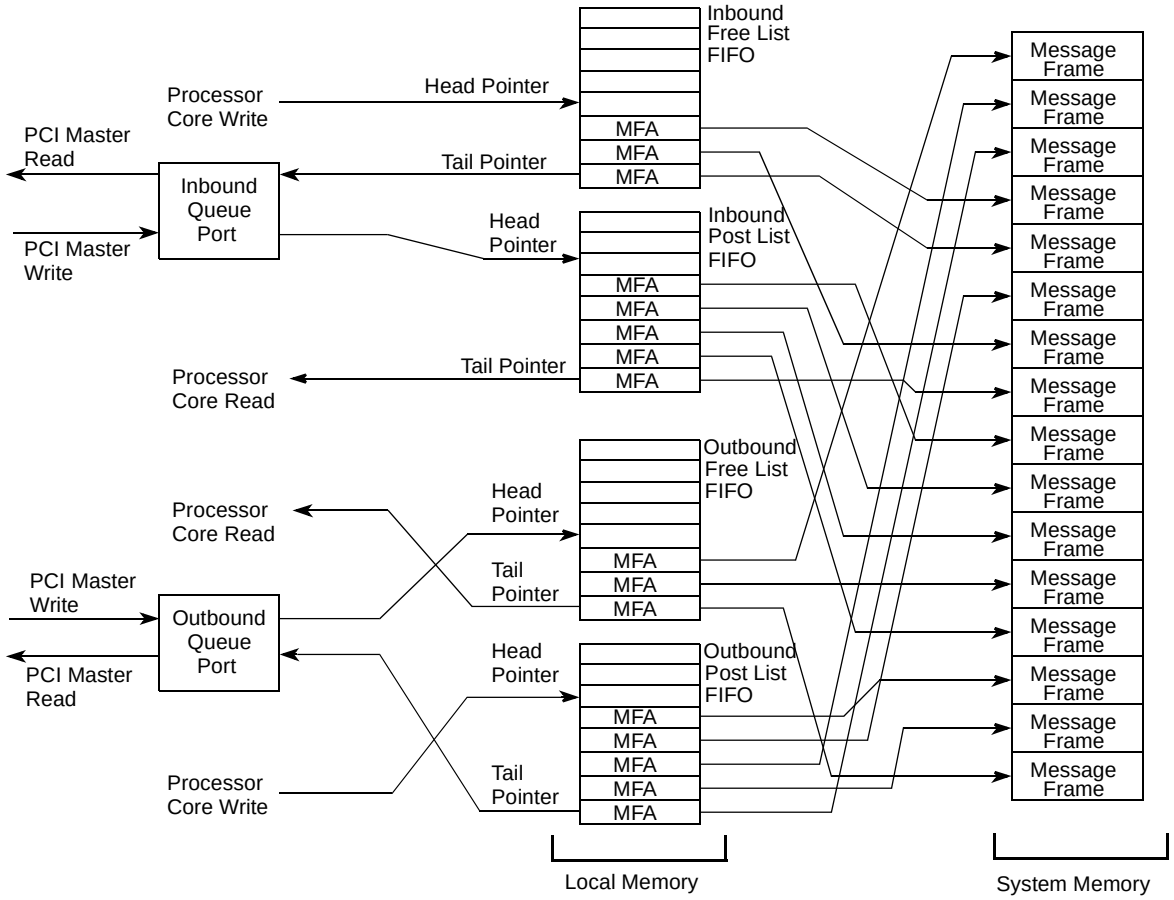


Figure 9-4. I_2O Message Queue Example

Table 9-7 lists the queue starting addresses for the FIFOs.

Table 9-7. Queue Starting Address

FIFO	Starting Address
Inbound free_list	QBA (specified in QBAR)
Inbound post_list	QBA + (1*FIFO size specified in MUCR)
Outbound post_list	QBA + (2*FIFO size specified in MUCR)
Outbound free_list	QBA + (3*FIFO size specified in MUCR)

The following subsections describe the inbound and outbound FIFOs of the I_2O interface.

9.3.3.1 Inbound FIFOs

The I_2O specification defines two inbound FIFOs: an inbound post_list FIFO and an inbound free_list FIFO. The inbound FIFOs allow external PCI masters to post messages to the processor core.

9.3.3.1.1 Inbound Free_List FIFO

The inbound free_list FIFO holds the list of empty inbound MFAs. The external PCI master reads the inbound FIFO queue port register (IFQPR), which returns the MFA pointed to by the inbound free_FIFO tail pointer register (IFTPR). The MPC8245's I_2O unit then automatically increments the value in IFTPR.

If the inbound free_list FIFO is empty (no free MFA entries), the unit returns 0xFFFF_FFFF.

9.3.3.1.2 Inbound Post_List FIFO

The inbound post_list FIFO holds MFAs that are posted to the processor core from external PCI masters. PCI masters external to the MPC8245 write to the head of the FIFO by writing the MFA to the inbound FIFO queue port register (IFQPR). The I_2O unit transfers the MFA to the location pointed to by the inbound post_FIFO head pointer register (IPHPR).

After the MFA is written to the FIFO, the MPC8245's I_2O unit automatically increments the value in IPHPR to set up for the next message. In addition, an interrupt is generated to the processor core through the PIC unit (provided the interrupt is not masked). The inbound post queue interrupt bit in the inbound message interrupt status register (IMISR[IPQI]) is set to indicate the condition. The processor core should clear the interrupt bit as part of the interrupt handler and read the message pointed to by the MFA located in the IPTPR. After the message has been read, the interrupt software must explicitly increment the value in IPTPR.

When the processor is done using the message, it must return the message to the inbound free_list FIFO.

9.3.3.2 Outbound FIFOs

The I_2O specification defines two outbound FIFOs: an outbound post_list FIFO and an outbound free_list FIFO. The outbound FIFOs send messages from the processor core to a remote host processor.

9.3.3.2.1 Outbound Free_List FIFO

The outbound free_list FIFO holds the MFAs of the empty outbound message locations in local memory. When the processor core is ready to send an outbound message, it obtains an MFA by reading the OFTPR; then it writes the message into the message frame. The OFTPR is managed by the processor core.

When an external PCI master is done using a message posted in the outbound post_list FIFO and needs to return the MFA to the free list, it writes to the outbound FIFO queue port register (OFQPR). The MPC8245 I_2O unit then automatically writes the MFA to the outbound free_FIFO head pointer register (OFHPR), causing the value in OFHPR to be automatically incremented.

9.3.3.2.2 Outbound Post_List FIFO

The outbound post_list FIFO holds MFAs that are posted from the processor core to remote processors. The processor core places messages in the outbound post_list FIFO by writing the MFA to OPHPR. This software must then increment the value in OPHPR.

When the FIFO is not empty (head and tail pointers are not equal), the outbound post_list queue interrupt bit in the outbound message interrupt status register (OMISR[OPQI]) is set. Additionally, the external MPC8245 PCI interrupt signal ($\overline{\text{INTA}}$) is asserted (if it is not masked). The outbound post_list queue interrupt can be masked using the outbound message interrupt mask register (OMIMR). Note that OPQIM must be cleared to allow OPQI to generate an interrupt.

An external PCI master reads the outbound FIFO queue port register (OFQPR) to cause the MPC8245's I_2O unit to read the MFA from local memory pointed to by the OPTPR. The I_2O unit then automatically increments the value in OPTPR.

When the FIFO is empty (head and tail pointers are equal), the unit returns 0xFFFF_FFFF.

9.3.4 I_2O Register Descriptions

The following sections provide detailed descriptions of the I_2O registers and some of the bits that control the generic message and doorbell register interface in these registers. See Chapter 11, "Programmable Interrupt Controller (PIC) Unit," for more information about the interrupt mechanisms of the MPC8245.

9.3.4.1 PCI-Accessible I_2O Registers

The OMISR, OMIMR, IFQPR, and OFQPR registers are used by PCI masters to access the MPC8245 I_2O unit. The processor core cannot access any of these registers.

9.3.4.1.1 Outbound Message Interrupt Status Register (OMISR)

The OMISR contains the interrupt status of the I_2O, I^2C, DUART, doorbell register, and outbound message register events as well as that of the two DMA channels and watchpoint match conditions that cause the assertion of $\overline{\text{INTA}}$. These events are generated by blocks in the MPC8245 and the assertion of $\overline{\text{INTA}}$ signals an interrupt to the PCI bus on behalf of these blocks.

Individual DMA interrupts (if enabled and unmasked) cause $\overline{\text{INTA}}$ to assert if DMR[IRQS] = 1. Similarly, enabled watchpoint match events cause $\overline{\text{INTA}}$ to assert if the WP_INTR_DIR bit in the WP_CONTROL register is set. Finally, if UDCR[PCII] is set, enabled UART interrupts cause $\overline{\text{INTA}}$ to assert. If I2CCR[PCII] is set, enabled I^2C interrupts cause $\overline{\text{INTA}}$ to assert.

Writing a 1 to a set bit in OMISR clears the bit (except for read-only bits). In the case of DMA interrupts, the interrupt status bits in OMISR for the two channels are cleared by writing a 1 to the appropriate bit in the DSR. In the case of watchpoint match events, the interrupt status bit in OMISR is cleared by writing a 1 to the WP_INTR_STS bit in WP_CONTROL. UART interrupts are signalled when the IID0 bit in UIIR is cleared (indicating a pending UART interrupt). Note that the IID0 bit is set (clearing the interrupt) by reading various UART registers as described in Chapter 12, “DUART Unit.” In the case of I^2C, interrupt status bits are cleared by writing 1 to the MIEN bit in the I2CCR as described in Section 10.3.2, “I2C Frequency Divider Register (I2CFDR)”. Software that is attempting to determine the source of the interrupts should always perform a logical AND between the OMISR bits and their corresponding mask bits in the OMIMR.

Figure 9-5 shows the bits of the OMISR.

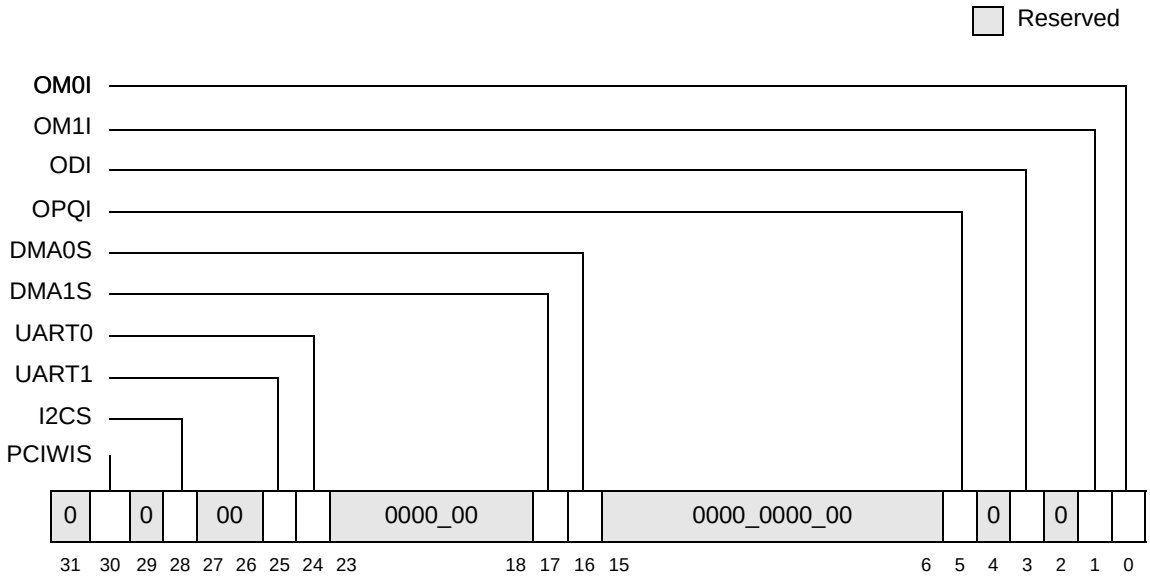


Figure 9-5. Outbound Message Interrupt Status Register (OMISR)

Table 9-8 shows the bit settings for the OMISR.

Table 9-8. OMISR Field Descriptions—Offset 0x030

Bits	Name	Reset Value	R/W	Description
31	—	All 0s	R	Reserved
30	PCIWIS	0	R	PCI watchpoint interrupt status. See Chapter 18, “Programmable I/O and Watchpoint,” for more information about interrupt routing for watchpoint matches. 0 No watchpoint match caused assertion of $\overline{\text{INTA}}$. 1 Indicates that a watchpoint match has occurred and watchpoint interrupts are routed to $\overline{\text{INTA}}$.
29	—	All 0s	R	Reserved
28	I2CS	0	R	I^2C interrupt status. See Section , “In some cases, the programmed value for the serial bit clock frequency (SCL) does not match the measured value because of the effect of DFFSR (sampling rate for the digital filter). Both DFFSR and FDR affect the speed of SCL. Six DFFSR intervals (three samples for high and three samples for low) are needed on the SCL to detect the true state of the clock. When the high or low is detected, the FDR value phase (half a cycle) is counted as normal. The frequency that is actually observed is:.” 0 No I^2C interrupt 1 Indicates I^2C interrupt condition
27-26	—	All 0s	R	Reserved
25	UART2	0	R	UART2 interrupt status. Chapter 12, “DUART Unit,” for more information. 0 No UART2 interrupt 1 Indicates a UART2 interrupt condition

Table 9-8. OMISR Field Descriptions—Offset 0x030 (continued)

Bits	Name	Reset Value	R/W	Description
24	UART1	0	R	UART1 interrupt status. Chapter 12, “DUART Unit,” for more information. 0 No UART1 interrupt 1 Indicates a UART1 interrupt condition
23-18	—	All 0s	R	Reserved
17	DMA1S	0	R	DMA channel 1 event status 0 No DMA1 event to report. 1 Indicates that a DMA event (end of transfer, end of segment, or error) has occurred on channel 1.
16	DMA0S	0	R	DMA channel 0 event status 0 No DMA0 event to report. 1 Indicates that a DMA event (end of transfer, end of segment, or error) has occurred on channel 0.
15–6	—	All 0s	R	Reserved
5	OPQI	0	R	Outbound post queue interrupt (I_2O interface) 0 No messages in the outbound queue—To clear this bit, software has to read all the MFAs in the outbound post_list FIFO. 1 Indicates that a message or messages are posted to the outbound post_list FIFO through the OFQPR and $\overline{\text{INTA}}$ will be generated (if not masked). This bit is set independently of the outbound post queue interrupt mask (OMIMR[OPQIM]) bit.
4	—	0	R	Reserved
3	ODI	0	R	Outbound doorbell interrupt 0 No outbound doorbell interrupt—This bit is automatically cleared when all bits in the ODBR are cleared. 1 Indicates an outbound doorbell interrupt condition (a bit in ODBR is set). Set independently of the mask bit in OMIMR.
2	—	0	R	Reserved
1	OM1I	0	Read Write 1 clears this bit	Outbound message 1 interrupt 0 No outbound message 1 interrupt 1 Indicates an outbound message 1 interrupt condition (a write occurred to OMR1). Set independently of the mask bit in OMIMR.
0	OM0I	0	Read Write 1 clears this bit	Outbound message 0 interrupt 0 No outbound message 0 interrupt 1 Indicates an outbound message 0 interrupt condition (a write occurred to OMR0). Set independently of the mask bit in OMIMR.

9.3.4.1.2 Outbound Message Interrupt Mask Register (OMIMR)

The OMIMR contains the interrupt masks of the I_2O, doorbell register and message register events that the MPC8245 generates.

Figure 9-6 shows the bits of the OMIMR.

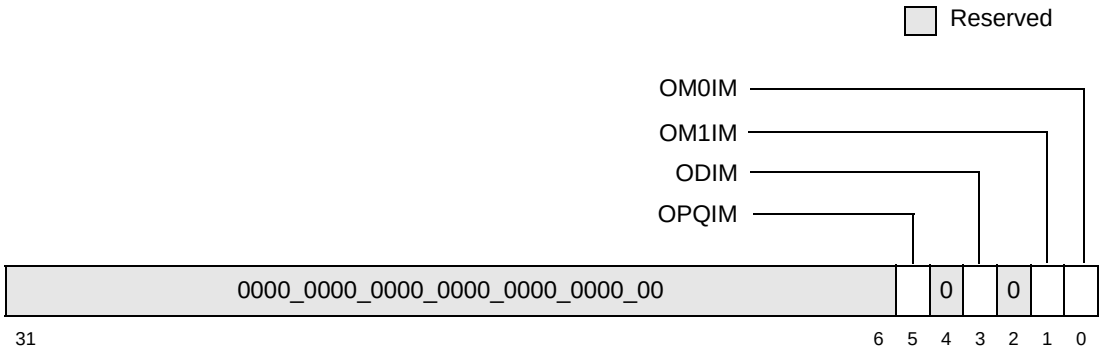


Figure 9-6. Outbound Message Interrupt Mask Register (OMIMR)

Table 9-9 shows the bit settings for the OMIMR.

Table 9-9. OMIMR Field Descriptions—Offset 0x034

Bits	Name	Reset Value	R/W	Description
31–6	—	All 0s	R	Reserved
5	OPQIM	0	R/W	Outbound post queue interrupt mask 0 Outbound post queue interrupt is allowed. 1 Outbound post queue interrupt is masked.
4	—	0	R	Reserved
3	ODIM	0	R/W	Outbound doorbell interrupt mask 0 Outbound doorbell interrupt is allowed. 1 Outbound doorbell interrupt is masked.
2	—	0	R	Reserved
1	OM1IM	0	R/W	Outbound message 1 interrupt mask 0 Outbound message 1 interrupt is allowed. 1 Outbound message 1 interrupt is masked.
0	OM0IM	0	R/W	Outbound message 0 interrupt mask 0 Outbound message 0 interrupt is allowed. 1 Outbound message 0 interrupt is masked.

9.3.4.1.3 Inbound FIFO Queue Port Register (IFQPR)

PCI masters use the IFQPR to access inbound messages in local memory. Figure 9-7 shows the bits of the IFQPR. Software should set MUCR[CQE] before accessing IFQPR.

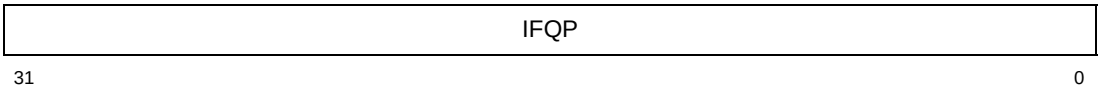


Figure 9-7. Inbound FIFO Queue Port Register (IFQPR)

Table 9-10 shows the bit settings for the IFQPR.

Table 9-10. IFQPR Field Descriptions—Offset 0x040

Bits	Name	Reset Value	R/W	Description
31–0	IFQP	All 0s	R/W	Inbound FIFO queue port. Reading this register returns the MFA from the inbound free_list FIFO. Writing to this register posts the MFA to the inbound post_list FIFO.

9.3.4.1.4 Outbound FIFO Queue Port Register (OFQPR)

PCI masters use the OFQPR to access outbound messages in local memory. Figure 9-8 shows the bits of the OFQPR. Software should set MUCR[CQE] before accessing OFQPR.

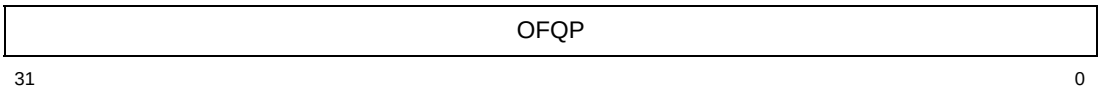


Figure 9-8. Outbound FIFO Queue Port Register (OFQPR)

Table 9-11 shows the bit settings for the OFQPR.

Table 9-11. OFQPR Field Descriptions—Offset 0x044

Bits	Name	Reset Value	R/W	Description
31–0	OFQP	All 0s	R/W	Outbound FIFO queue port. Reading this register returns the MFA from the outbound post_list FIFO. Writing to this register posts the MFA to the outbound free_list FIFO.

9.3.4.2 Processor-Accessible I_2O Registers

The following sections describe the I_2O registers accessible by the processor core and some of the bits that control the generic message and doorbell register interface in these registers.

9.3.4.2.1 Inbound Message Interrupt Status Register (IMISR)

The IMISR contains the interrupt status of the I_2O, doorbell register, message register, and watchpoint match events. These events are routed to the processor core through the PIC unit from the MU with the internal $\overline{int}$ or $\overline{mcp}$ signals, as Table 9-12 shows. See Chapter 11, “Programmable Interrupt Controller (PIC) Unit,” for more information about the assertion of $\overline{int}$ and Chapter 14, “Error Handling,” for more information about the enabling of machine check exceptions to the processor core. Note that enabled watchpoint match events cause $\overline{INT}$ to assert if the WP_INTR_DIR bit in the WP_CONTROL register is cleared.

Writing a 1 to a set bit in IMISR clears the bit (except for read-only bits). The processor core interrupt handling software must service these interrupts and clear these interrupt bits. Software attempting to determine the source of the interrupts should always perform a

logical AND between the IMISR bits and their corresponding mask bits in the IMIMR. In case of doorbell machine check or interrupt conditions, the corresponding read-only bits in IMISR (DMC and IDI) are cleared by writing a 1 to the corresponding machine check and interrupt bits in IDBR (causing them to be cleared). In the case of a watchpoint match event, the interrupt status bit (LWIS) in IMISR is cleared by writing a 1 to the WP_INTR_STS bit in the WP_CONTROL register.

Figure 9-9 shows the bits of the IMISR.

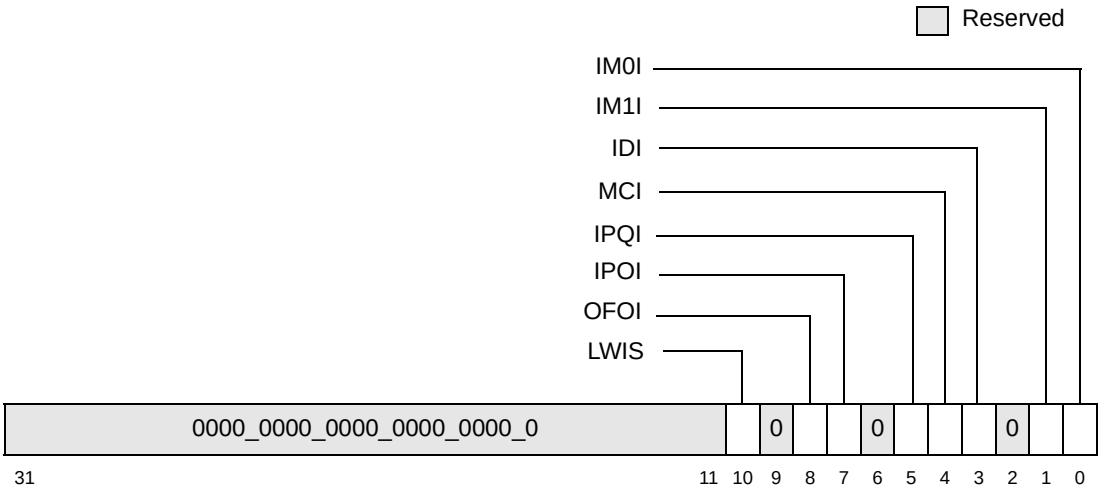


Figure 9-9. Inbound Message Interrupt Status Register (IMISR)

Table 9-12 shows the bit settings for the IMISR.

Table 9-12. IMISR Field Descriptions—Offset 0x0_0100

Bits	Name	Reset Value	R/W	Description
31-11	—	All 0s	R	Reserved
10	LWIS	0	Read	Local watchpoint interrupt status. See Chapter 18, “Programmable I/O and Watchpoint,” for more information about interrupt routing for watchpoint matches. 0 No watchpoint match caused assertion of INT. Cleared when WP_INTR_STS bit in WP_CONTROL bit is cleared (write 1 clears WP_INTR_STS). 1 Indicates that a watchpoint match has occurred and watchpoint interrupts are routed to INT.
9	—	0	R	Reserved
8	OFO	0	Read Write 1 clears this bit	Outbound free_list overflow condition 0 No overflow condition 1 Indicates that the outbound free_list FIFO head pointer is equal to the outbound free_list FIFO tail pointer and the queue is full. A machine check is signalled to the processor core through the internal *mcp* signal and a machine check exception is taken (if enabled). See Chapter 14, “Error Handling.” This bit is set only if the OFOM mask bit in IMIMR is cleared.

Table 9-12. IMISR Field Descriptions—Offset 0x0_0100 (continued)

Bits	Name	Reset Value	R/W	Description
7	IPO	0	Read Write 1 clears this bit	Inbound post_list overflow condition 0 No overflow condition 1 Indicates that the inbound free_list FIFO head pointer is equal to the inbound free_list FIFO tail pointer and the queue is full. A machine check is signalled to the processor core through the internal *mcp* signal and a machine check exception is taken (if enabled). This bit is set only if the IPOM mask bit in IMIMR is cleared.
6	—	0	R	Reserved
5	IPQI	0	Read Write 1 clears this bit	Inbound post queue interrupt (I_2O interface) 0 No MFA in the IFQPR 1 Indicates that the PCI master has posted an MFA to the inbound post_list FIFO through the IFQPR. Interrupt is signalled to the processor core through the internal *mcp* signal if the inbound post queue interrupt mask (IMIMR[IPQIM]) bit is cleared. This bit is set independently of IMIMR[IPQIM].
4	DMC	0	R	Doorbell register machine check condition 0 No doorbell register machine check condition. This bit is cleared when IDBR[MC] is cleared. 1 Indicates that a remote processor has generated a machine check condition (causing assertion of *mcp*) by setting IDBR[MC] and clearing IMIMR[MCIM]. This bit is set independently of IMIMR[MCIM].
3	IDI	0	R	Inbound doorbell interrupt 0 No inbound doorbell interrupt. This bit is cleared when the processor core clears IDBR[30–0]. 1 Indicates that at least one of IDBR[30–0] is set. Interrupt is signalled to the processor core through the internal *int* signal if IMIMR[IDIM] is cleared. This bit is set independently of IMIMR[IDIM].
2	—	0	R	Reserved
1	IM1I	0	Read; write 1 clears this bit	Inbound message 1 interrupt 0 No inbound message 1 interrupt. 1 Indicates an inbound message 1 interrupt condition (a write occurred to IMR1 from a remote PCI master). Interrupt is signalled to the processor core through the internal *int* signal if IMIMR[IM1IM] is cleared. This bit is set independently of IMIMR[IM1IM].
0	IM0I	0	Read; write 1 clears this bit	Inbound message 0 interrupt 0 No inbound message 0 interrupt 1 Indicates an inbound message 0 interrupt condition (a write occurred to IMR0 from a remote PCI master). Interrupt is signalled to the processor core through the internal *int* signal if IMIMR[IM0IM] is cleared. This bit is set independently of IMIMR[IM0IM].

9.3.4.2.2 Inbound Message Interrupt Mask Register (IMIMR)

The IMIMR contains the interrupt mask of the I_2O, doorbell register and message register events generated by a remote PCI master. Figure 9-10 shows the bits of the IMIMR.

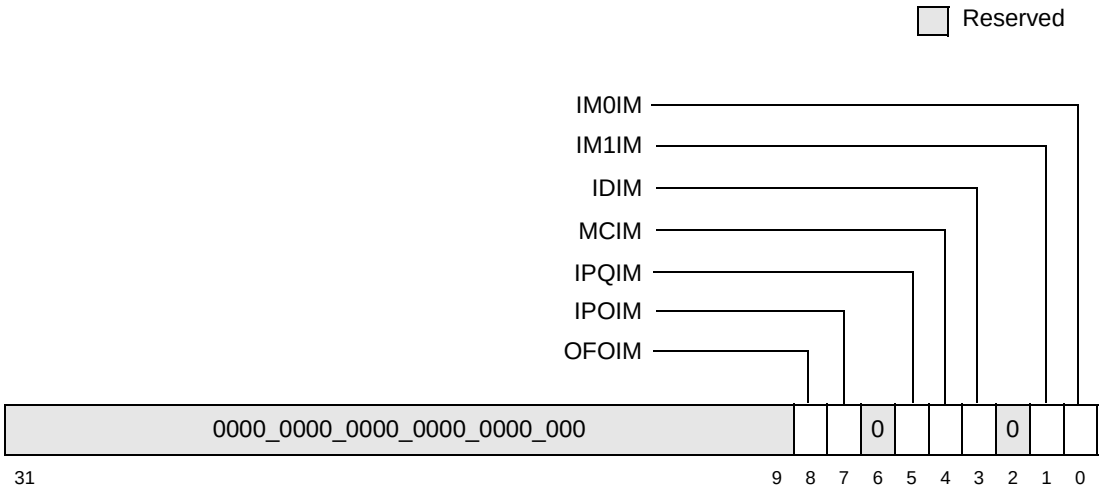


Figure 9-10. Inbound Message Interrupt Mask Register (IMIMR)

Table 9-13 shows the bit settings for the IMIMR.

Table 9-13. IMIMR Field Descriptions—Offset 0x0_0104

Bits	Name	Reset Value	R/W	Description
31–9	—	All 0s	R	Reserved
8	OFOM	0	R/W	Outbound free_list overflow mask 0 Outbound free_list overflow is allowed (and causes assertion of $\overline{mcp}$). 1 Outbound free_list overflow is masked.
7	IPOM	0	R/W	Inbound post_list overflow mask 0 Inbound post_list overflow is allowed (and causes assertion of $\overline{mcp}$). 1 Inbound post_list overflow is masked.
6	—	0	R	Reserved
5	IPQIM	0	R/W	Inbound post queue interrupt mask 0 Inbound post queue interrupt is allowed. 1 Inbound post queue interrupt is masked.
4	DMCM	0	R/W	Doorbell register machine check mask 0 Doorbell machine check ($\overline{mcp}$) from IDBR[MC] is allowed. 1 Doorbell machine check ($\overline{mcp}$) from IDBR[MC] is masked.
3	IDIM	0	R/W	Inbound doorbell interrupt mask 0 Inbound doorbell interrupt is allowed. 1 Inbound doorbell interrupt is masked.
2	—	0	R	Reserved

Table 9-13. IMIMR Field Descriptions—Offset 0x0_0104 (continued)

Bits	Name	Reset Value	R/W	Description
1	IM1IM	0	R/W	Inbound message 1 interrupt 0 Inbound message 1 interrupt is allowed. 1 Inbound message 1 interrupt is masked.
0	IM0IM	0	R/W	Inbound message 0 interrupt 0 Inbound message 0 interrupt is allowed. 1 Inbound message 0 interrupt is masked.

9.3.4.2.3 Inbound Free_FIFO Head Pointer Register (IFHPR)

Free MFAs are posted by the processor core to the inbound free_list FIFO pointed to by the inbound free_FIFO head pointer register (IFHPR). The processor core is responsible for updating the contents of IFHPR. Figure 9-11 shows the bits of the IFHPR.

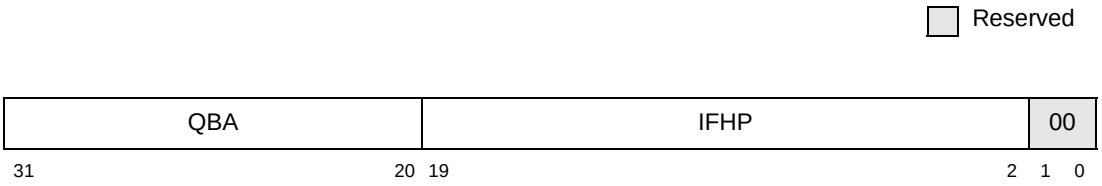


Figure 9-11. Inbound Free_FIFO Head Pointer Register (IFHPR)

Table 9-14 shows the bit settings for the IFHPR.

Table 9-14. IFHPR Field Descriptions—Offset 0x0_0120

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	IFHP	All 0s	R/W	Inbound free_FIFO head pointer. The processor maintains the local memory offset of the head pointer of the inbound free _list FIFO in this field.
1–0	—	00	R	Reserved

9.3.4.2.4 Inbound Free_FIFO Tail Pointer Register (IFTPR)

PCI masters pick up free MFAs from the inbound free_list FIFO pointed to by the inbound free_FIFO tail pointer register (IFTPR). The actual PCI reads of MFAs are performed through the inbound FIFO queue port register (IFQPR). The MPC8245 automatically increments the IFTP value after every read from IFQPR. Figure 9-12 shows the bits of the IFTPR.

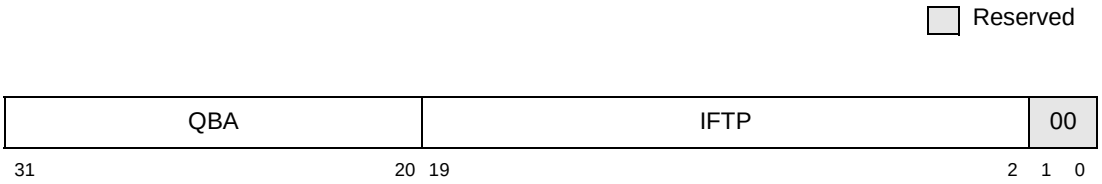


Figure 9-12. Inbound Free_FIFO Tail Pointer Register (IFTPR)

Table 9-15 shows the bit settings for the IFTPR.

Table 9-15. IFTPR Field Descriptions—Offset 0x0_0128

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	IFTP	All 0s	R/W	Inbound free_FIFO tail pointer. Maintains the local memory offset of the tail pointer of the inbound free _list FIFO.
1–0	—	00	R	Reserved

9.3.4.2.5 Inbound Post_FIFO Head Pointer Register (IPHPR)

PCI masters post MFAs to the inbound post_list FIFO pointed to by the inbound post_FIFO head pointer register (IPHPR). The actual PCI writes are performed through the inbound FIFO queue port register (IFQPR). The MPC8245 automatically increments the IPHP value after every write to IFQPR. Figure 9-13 shows the bits of the IPHPR.

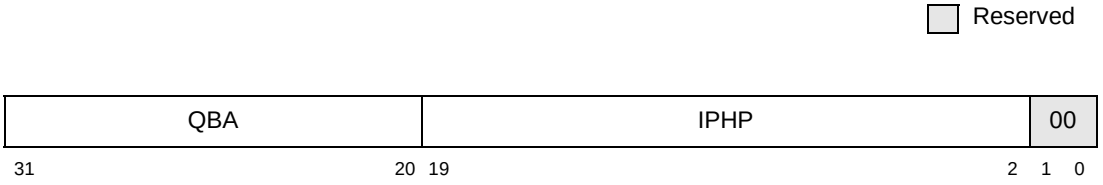


Figure 9-13. Inbound Post_FIFO Head Pointer Register (IPHPR)

Table 9-16 shows the bit settings for the IPHPR.

Table 9-16. IPHPR Field Descriptions—Offset 0x0_0130

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	IPHP	All 0s	R/W	Inbound post_FIFO head pointer. Maintains the local memory offset of the head pointer of the inbound post _list FIFO.
1–0	—	00	R	Reserved

9.3.4.2.6 Inbound Post_FIFO Tail Pointer Register (IPTPR)

The processor picks up MFAs posted by PCI masters from the inbound post_list FIFO pointed to by the inbound post_FIFO tail pointer register (IPTPR). The processor core is responsible for updating the contents of IPTPR. Figure 9-14 shows the bits of the IPTPR.

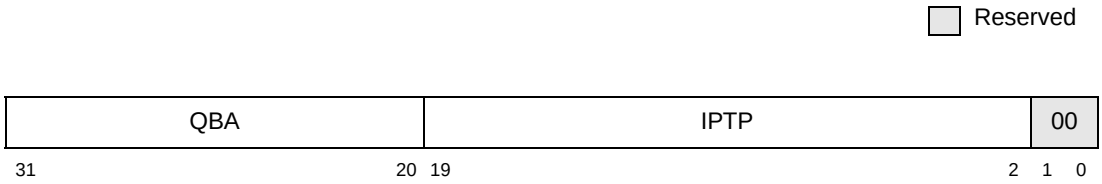


Figure 9-14. Inbound Post_FIFO Tail Pointer Register (IPTPR)

Table 9-17 shows the bit settings for the IPTPR.

Table 9-17. IPTPR Field Descriptions—Offset 0x0_0138

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	IPTP	All 0s	R/W	Inbound post_FIFO tail pointer. The processor maintains the local memory offset of the inbound post_list FIFO tail pointer in this field.
1–0	—	00	R	Reserved

9.3.4.2.7 Outbound Free_FIFO Head Pointer Register (OFHPR)

PCI masters return free MFAs to the inbound free_list FIFO pointed to by the inbound free_FIFO head pointer register (IFHPR). The actual PCI writes of MFAs are performed through the outbound FIFO queue port register (OFQPR). The MPC8245 automatically increments the OFTP value after every read from OFQPR. Figure 9-15 shows the bits of the OFHPR.

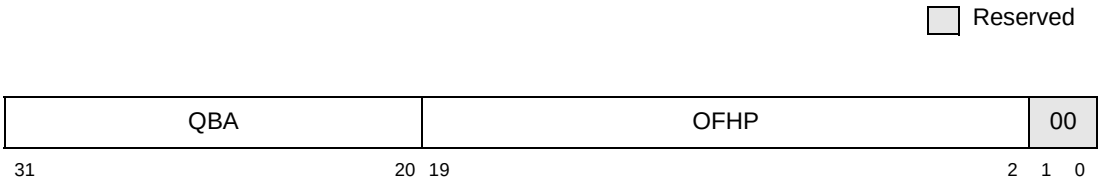


Figure 9-15. Outbound Free_FIFO Head Pointer Register (OFHPR)

Table 9-18 shows the bit settings for the OFHPR.

Table 9-18. OFHPR Field Descriptions—Offset 0x0_0140

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	OFHP	All 0s	R/W	Outbound free_FIFO head pointer. Maintains the local memory offset of the head pointer of the outbound free_list FIFO.
1–0	—	0	R	Reserved

9.3.4.2.8 Outbound Free_FIFO Tail Pointer Register (OFTPR)

The processor picks up free MFAs from the outbound free_list FIFO pointed to by the outbound free_FIFO tail pointer register (OFTPR). The processor core is responsible for updating the contents of OFTPR. Figure 9-16 shows the bits of the OFTPR.

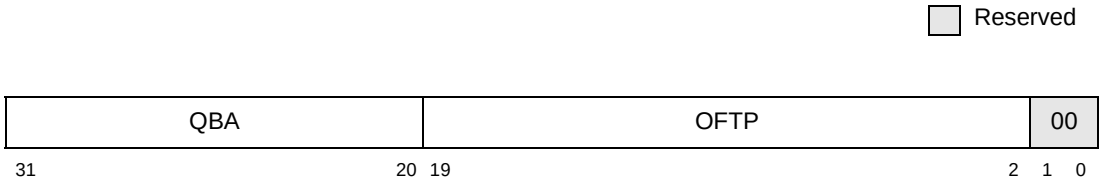


Figure 9-16. Outbound Free_FIFO Tail Pointer Register (OFTPR)

Table 9-19 shows the bit settings for the OFTPR.

Table 9-19. OFTPR Field Descriptions—Offset 0x0_0148

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	OFTP	All 0s	R/W	Outbound free_FIFO tail pointer. The processor maintains the local memory offset of the tail pointer of the outbound free_list FIFO in this field.
1–0	—	00	R	Reserved

9.3.4.2.9 Outbound Post_FIFO Head Pointer Register (OPHPR)

The processor core posts MFAs to the outbound post_list FIFO pointed to by the outbound post_FIFO head pointer register (OPHPR). The processor core is responsible for updating the contents of OPHPR. Figure 9-17 shows the bits of the OPHPR.

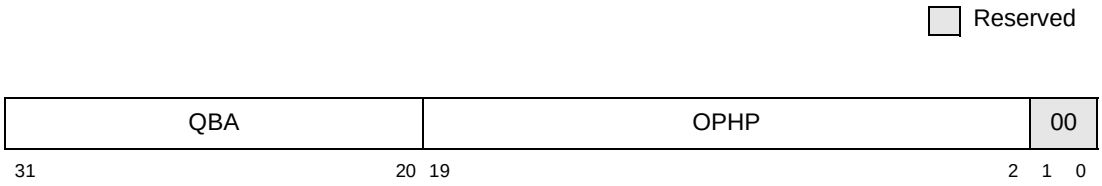


Figure 9-17. Outbound Post_FIFO Head Pointer Register (OPHPR)

Table 9-20 shows the bit settings for the OPHPR.

Table 9-20. OPHPR Field Descriptions—Offset 0x0_0150

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	OPHP	All 0s	R/W	Outbound post_FIFO head pointer. The processor maintains the local memory offset of the head pointer of the outbound post_list FIFO in this field.
1–0	—	00	R	Reserved

9.3.4.2.10 Outbound Post_FIFO Tail Pointer Register (OPTPR)

PCI masters pick up posted MFAs from the outbound post_list FIFO pointed to by the outbound post_FIFO tail pointer register (OPTPR). The actual PCI reads of MFAs are performed through the outbound FIFO queue port register (OFQPR). The MPC8245 automatically increments the OPTP value after every read from OFQPR.

Figure 9-18 shows the bits of the OPTPR.

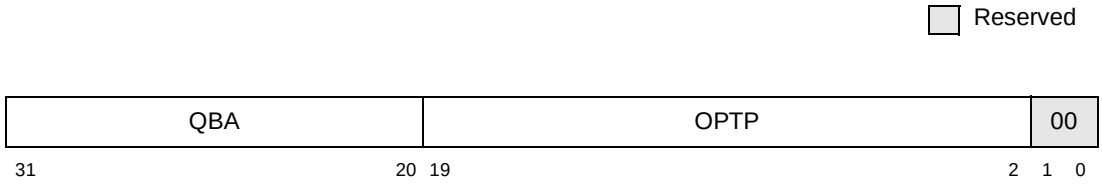


Figure 9-18. Outbound Post_FIFO Tail Pointer Register (OPTPR)

Table 9-21 shows the bit settings for the OPTPR.

Table 9-21. OPTPR Field Descriptions— Offset 0x0_0158

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R	Queue base address. When read, this field returns the contents of QBAR[31–20].
19–2	OPTP	All 0s	R/W	Outbound post_FIFO tail pointer. Maintains the local memory offset of the tail pointer of the outbound post_list FIFO.
1–0	—	00	R	Reserved

9.3.4.2.11 Messaging Unit Control Register (MUCR)

The MUCR allows software to enable and set up the size of the inbound and outbound FIFOs. Figure 9-19 shows the bits of the MUCR.

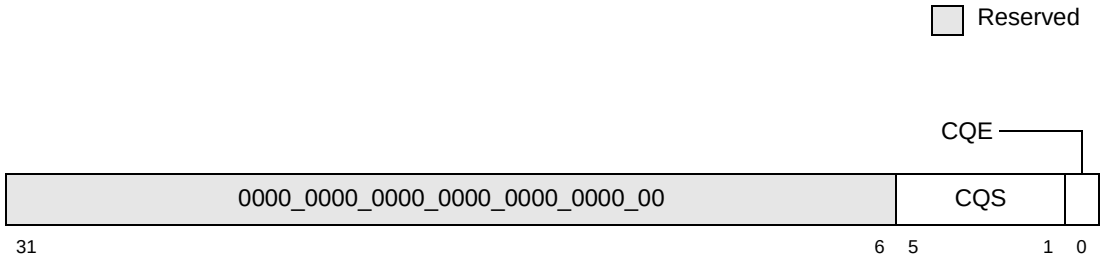


Figure 9-19. Messaging Unit Control Register (MUCR)

Table 9-22 shows the bit settings for the MUCR.

Table 9-22. MUCR Field Descriptions— Offset 0x0_0164

Bits	Name	Reset Value	R/W	Description
31–6	—	All 0s	R	Reserved
5–1	CQS	0b0_0001	R/W	Circular queue size 0b0_0001: 4K entries (16 Kbytes) 0b0_0010: 8K entries (32 Kbytes) 0b0_0100: 16K entries (64 Kbytes) 0b0_1000: 32K entries (128 Kbytes) 0b1_0000: 64K entries (256 Kbytes)
0	CQE	0	R/W	Circular queue enable 0 PCI writes to IFQPR and OFQPR are ignored and reads return 0xFFFF_FFFF. 1 Allows PCI masters to access the inbound and outbound queue ports (IFQPR and OFQPR). Usually, this bit is set only after software has initialized all pointers and configuration registers.

9.3.4.2.12 Queue Base Address Register (QBAR)

The QBAR specifies the beginning address of the circular queue structure in local memory. Figure 9-20 shows the bits of the QBAR.

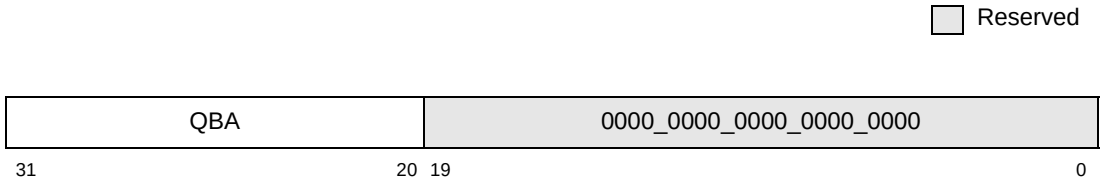


Figure 9-20. Queue Base Address Register (QBAR)

Table 9-23 shows the bit settings for the QBAR.

Table 9-23. QBAR Field Descriptions— Offset 0x0_0170

Bits	Name	Reset Value	R/W	Description
31–20	QBA	All 0s	R/W	Queue base address. Base address of circular queue in local memory. Note that the circular queue must be aligned on a 1-Mbyte boundary.
19–0	—	All 0s	R	Reserved

Chapter 10
I²C Interface

This chapter describes the I²C (inter-integrated circuit) interface on the MPC8245.

10.1 I²C Interface Overview

The I²C interface is a two-wire, bidirectional serial bus developed by Philips that provides a simple, efficient way to exchange data between integrated circuit (IC) devices. The I²C interface allows the MPC8245 to exchange data with other I²C devices such as microcontrollers, EEPROMs, real-time clock devices, A/D converters, and LCDs. The two-wire bus with serial data and serial clock minimizes device interconnections. The synchronous, multimaster bus of the I²C allows the connection of additional devices to the bus for expansion and system development.

The I²C interface is a true multimaster bus that includes collision detection and arbitration that prevent data corruption if two or more masters attempt to control the bus simultaneously. This feature allows for complex applications with multiprocessor control.

10.1.1 I²C Unit Features

The I²C unit on the MPC8245 consists of a transmitter/receiver unit, a clocking unit, and a control unit. Some of the features of the I²C unit are as follows:

- Two-wire interface
- Multimaster support
- Master or slave I²C mode support
- Software-programmable for one of 64 different serial clock frequencies
- Software-selectable acknowledge bit
- Interrupt-driven, byte-to-byte data transfer
- Arbitration-lost interrupt with automatic mode switching from master to slave
- Calling address identification interrupt
- START and STOP condition generation/detection
- Repeated START condition generation
- Acknowledge bit generation/detection

- Bus-busy detection
- Programmable on-chip digital filter rejecting electrical spikes on the bus
- Module reset through software
- Registers accessible through PCI interface or the processor
- Programmable interrupts directed to PCI bus or the processor
- General broadcast support

10.1.2 I²C Interface Signal Summary

The I²C interface uses the serial data (SDA) signal and serial clock (SCL) signal for data transfer. All devices connected to these two signals must have open-drain or open-collector outputs. A logical AND function is performed on both signals with external pull-up resistors. Note that the signal patterns driven on SDA represent address, data, or read/write information at different stages of the protocol.

Table 10-1 summarizes information about the two signals that comprise the I²C interface.

Table 10-1. I²C Interface Signal Description

Signal Name	Idle State	I/O	State Meaning
SCL (serial clock)	HIGH	I	When the MPC8245 is idle or acts as a slave, SCL defaults as an input. The unit uses SCL to synchronize incoming data on SDA. The bus is assumed to be busy when SCL is detected low.
		O	As a master, the MPC8245 drives SCL along with SDA when transmitting. As a slave, the MPC8245 drives SCL low for data pacing.
SDA (serial data)	HIGH	I	When the MPC8245 is idle or in a receiving mode, SDA defaults as an input. The unit receives data from other I²C devices on SDA. The bus is assumed to be busy when SDA is detected low.
		O	When writing as a master or slave, the MPC8245 drives data on SDA synchronous to SCL.

10.1.3 I²C Register Summary

Five registers in the I²C unit are used for the address, data, configuration, control, and status of the I²C interface. These registers are located in the embedded utilities memory block (see Section 3.4, “Embedded Utilities Memory Block (EUMB)”).

Table 10-2 summarizes the I²C registers. Complete descriptions of these registers are provided in Section 10.3, “I2C Register Descriptions.”

Table 10-2. I²C Register Summary

PCI Configuration Offset	Local Memory Offset	Register Name
0x0_0400	0x0_3000 or 0x3400	I²C address register (I2CADR)
0x0_0404	0x0_3004 or 0x0_3404	I²C frequency divider register (I2CFDR)
0x0_0408	0x0_3008 or 0x0_3408	I²C control register (I2CCR)
0x0_040C	0x0_300C or 0x0_340C	I²C status register (I2CSR)
0x0_0410	0x0_3010 or 0x0_3410	I²C data register (I2CDR)

10.1.4 I²C Block Diagram

Because the reset state of the I²C interface is as a slave receiver, the I²C unit always defaults to slave receiver operation when not explicitly programmed to be a master or to respond to a slave transmitter address. Figure 10-1 shows a block diagram of the I²C unit.

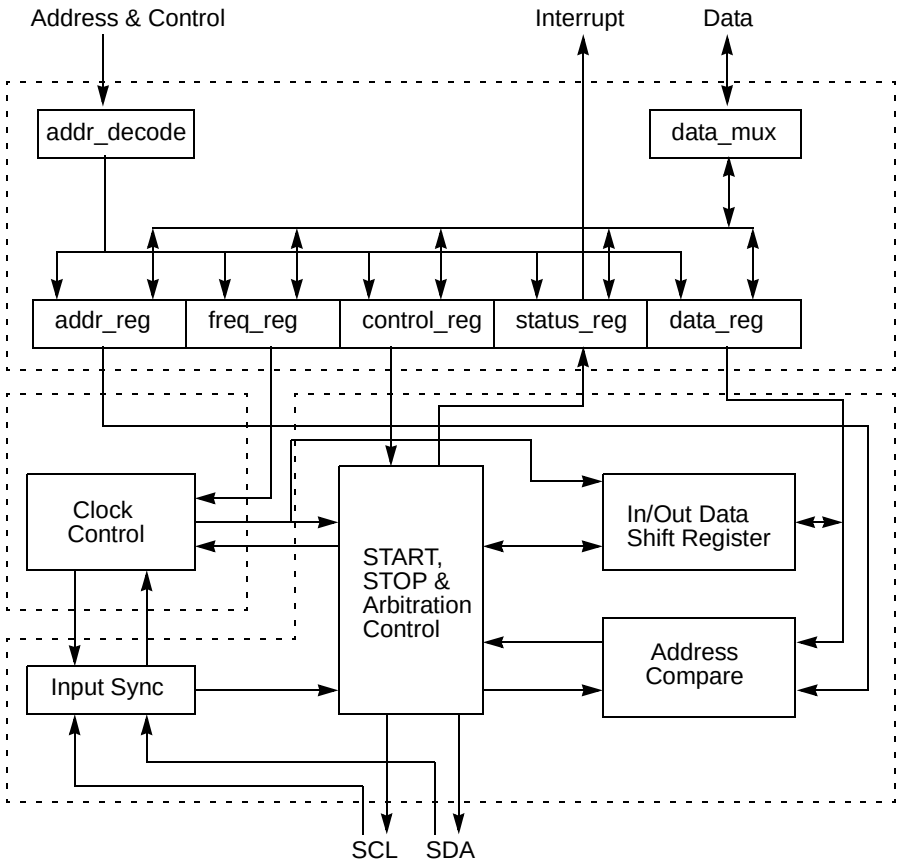


Figure 10-1. I²C Interface Block Diagram

10.2 I2C Protocol

A standard I2C transfer consists of four parts:

- START condition
- Slave target address transmission
- Data transfer
- STOP condition

Figure 10-2 shows the interaction of these four parts and the calling address, data byte, and new calling address components of the I2C protocol. The details of the protocol are described in the following subsections.

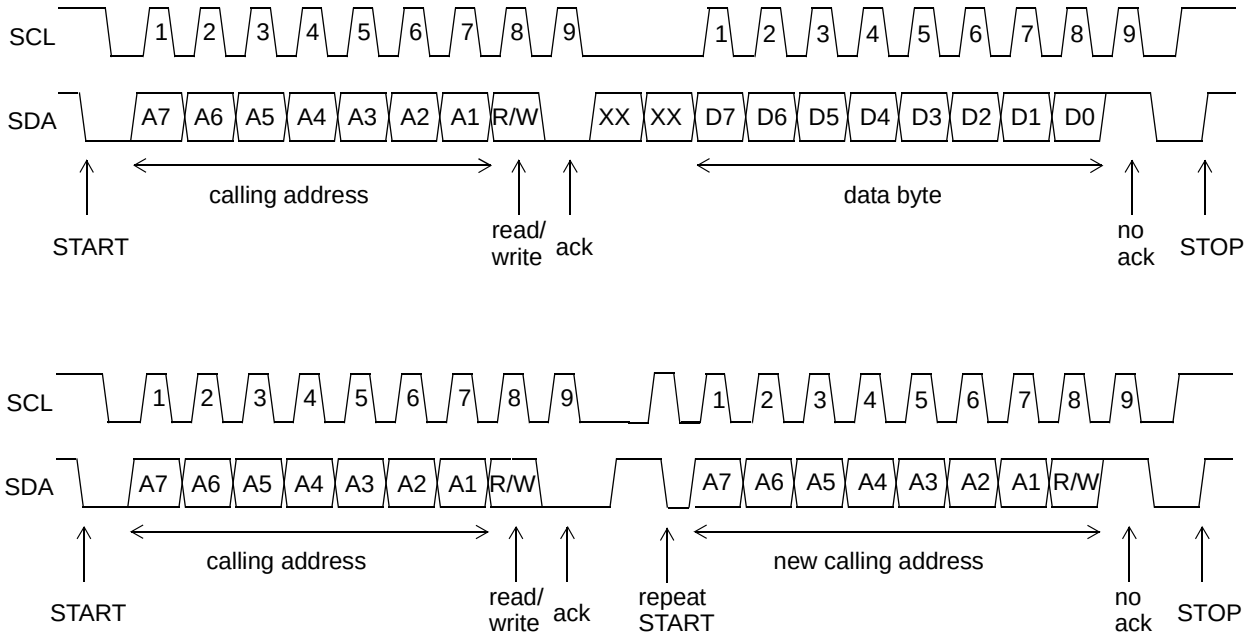


Figure 10-2. I2C Interface Transaction Protocol

10.2.1 START Condition

When not engaged, the bus SDA and SCL lines are at logic high. A master can send a START condition to initiate a transfer. As Figure 10-2 shows, a START condition is a high-to-low transition of SDA while SCL is high, and denotes the beginning of a new data transfer. Each data transfer can contain several bytes and awakens all slaves.

10.2.2 Slave Address Transmission

The first byte of data that the master transfers immediately after the START condition is the slave address, a seven-bit calling address followed by a R/$\overline{W}$ bit, which indicates the direction of the data that is transferred to the slave. No two slaves in the system can have

the same address. Furthermore, when the I²C device is operating as a master, it must not transmit an address that is identical to its slave address. An I²C device cannot be master and slave at the same time.

Only the slave with a calling address that matches the one that the master transmitted responds by returning an acknowledge bit (pulling the SDA signal low at the 9th clock) (see Figure 10-2). If no slave acknowledges the address, the master should generate a STOP condition or a repeated START condition.

When slave addressing is successful (and SCL returns to zero), the data transfer can proceed on a byte-to-byte basis in the direction specified by the R/$\overline{W}$ bit that the calling master sent.

The MPC8245 responds to a general call (broadcast) command when I2CCR[BCST] is set. A broadcast address is always zero; it does not depend on the I2CADR value. The second byte of the broadcast message is the master device ID. Because hardware automatically acknowledges the second byte, the receiver device software must read the second byte of the message to verify that the broadcast message is intended for itself. If the device ID signifies another receiver device and the third byte is a write command, software can ignore the third byte during the broadcast. If the device ID signifies another receiver device and the third byte is a read command, software must write 0xFF to the I2CDR with I2CCR[TXAK] = 1 so that it does not interfere with the data written from the addressed device.

Each data byte is eight bits long. Data bits can be changed only while the SCL signal is low and must be held stable while the SCL signal is high, as Figure 10-2 shows. One clock pulse is on SCL for each data bit, and the most significant bit (msb) is transmitted first. An acknowledge bit that is signalled from the receiving device by pulling the SDA line low at the ninth clock must follow each byte of data. Therefore, one complete data byte transfer takes nine clock pulses. Several bytes can be transferred during a data transfer session.

If the slave receiver does not acknowledge the master, the SDA line must be left high by the slave. The master can then generate a stop condition to abort the data transfer or a START condition (repeated START) to begin a new calling.

If the master receiver does not acknowledge the slave transmitter after a byte of transmission, the slave interprets that the end-of-data was reached. Subsequently, the slave releases the SDA line and the master generates a STOP or a START condition.

10.2.3 Repeated START Condition

As Figure 10-2 shows, a repeated START condition is generated without a STOP condition to terminate the previous transfer. The master uses this method to communicate with another slave or with the same slave in a different mode (transmit/receive mode) without releasing the bus.

10.2.4 STOP Condition

To terminate the transfer, the master can generate a STOP condition to free the bus. A STOP condition is defined as a low-to-high transition of the SDA signal while SCL is high. For more information, see Figure 10-2. Note that a master can generate a STOP even if the slave transmitted an acknowledge bit, when the slave must release the bus.

As described in Section 10.2.3, “Repeated START Condition,” the master can generate a repeated START condition, which is a START condition followed by a calling address without generating a STOP condition for the previous transfer.

10.2.5 Arbitration Procedure

The I2C interface is a true multiple master bus that allows more than one master device to be connected on it. If two or more masters simultaneously try to control the bus, each master’s clock synchronization procedure (including the MPC8245) determines the bus clock. The low period is equal to the longest clock low period, and the high is equal to the shortest one among the masters. A bus master loses arbitration if it transmits a logic 1 on SDA while another master transmits a logic 0. The losing masters immediately switch over to slave-receive mode and stop driving the SDA line. In that case, the transition from master to slave mode does not generate a STOP condition. Meanwhile, the I2C unit sets the I2CSR[MAL] status bit to indicate the loss of arbitration and, as a slave, services the transaction if directed to itself.

Arbitration is lost (and I2CSR[MAL] is set) in the following circumstances:

- SDA is sampled as low when the master drives a high during address or data-transmit cycle.
- SDA is sampled as low when the master drives a high during the acknowledge bit of a data-receive cycle.
- A START condition is attempted when the bus is busy.
- A repeated START condition is requested in slave mode.

NOTE

The MPC8245 does not automatically retry a failed transfer attempt.

If the I2C module of the MPC8245 is enabled in the middle of an ongoing byte transfer, the interface behaves as follows:

- In slave mode, the MPC8245 ignores the current transfer on the bus and starts operating whenever a subsequent START condition is detected.
- In master mode, the MPC8245 is not aware that the bus is busy. If a START condition is initiated, the current bus cycle can become corrupt, which ultimately

causes the current bus master of the I2C interface to lose arbitration. Bus operations subsequently return to normal.

10.2.6 Clock Synchronization

Because the wire AND logic is on the SCL line, a high-to-low transition on the SCL line affects all devices that are connected on the bus. The devices begin counting their low period when the master drives the SCL line low. When a device drives SCL low, it holds the SCL line low until the clock high state is reached. However, the change of low-to-high in a device clock might not change the state of the SCL line if another device is still within its low period. The device with the longest low period holds the synchronized clock SCL low. Devices with shorter low periods enter a high wait state during this time. When all concerned devices have counted off their low period, the synchronized SCL line is released and pulled high. No differences occur between the devices' clocks and the state of the SCL line, and all the devices begin counting their high periods. The first device to complete its high period pulls the SCL line low again.

10.2.7 Handshaking

The clock synchronization mechanism can be used as a handshake in data transfer. A slave device can hold the SCL low after completing one byte transfer (9 bits). In such cases, it halts the bus clock and forces the master clock into wait states until the slave releases the SCL line.

10.2.8 Clock Stretching

Slaves can use the clock synchronization mechanism to slow the transfer bit rate. After the master drives the SCL line low, the slave can drive SCL low for the required period and then release it. If the slave SCL low period is greater than the master SCL low period, the resulting SCL bus signal low period is stretched.

10.3 I2C Register Descriptions

This section describes the I2C registers in detail.

NOTE

Although reserved fields return 0, programmers should not assume that result. Reserved bits should always be written with the value that they returned when read. Program the register by reading the value, modifying the appropriate fields, and writing back the value.

This information does not apply to the I2C data register (I2CDR).

The I²C registers in this chapter are shown in little-endian format. If the system is big-endian, software must swap the bytes appropriately.

10.3.1 I²C Address Register (I2CADR)

As Figure 10-3 shows, the I2CADR contains the address to which I²C interface responds when addressed as a slave. Note that it is not the address that is sent on the bus during the address calling cycle when the MPC8245 is in master mode.

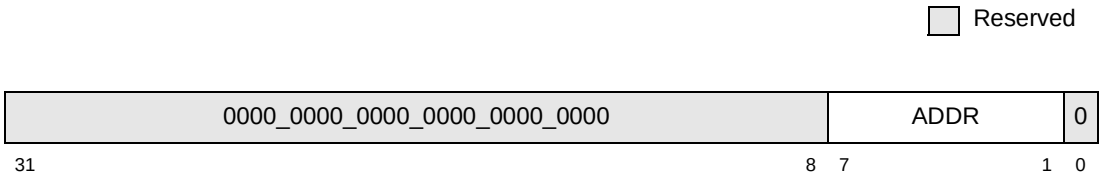


Figure 10-3. I²C Address Register (I2CADR)

Table 10-3 describes the bit settings of I2CADR.

Table 10-3. I2CADR Field Descriptions—Offset 0x0_3000

Bits	Name	Reset Value	R/W	Description
31–8	—	All zeros	R	Reserved
7–1	ADDR	0x00	R/W	Slave address. Contains the specific address to which the MPC8245 responds as a slave on the I²C interface. Note that the default mode of the I²C interface is slave mode for an address match. Also note that this address does not need to be zero to respond to a general broadcast if I2CCR[BCST] = 1.
0	—	0	R	Reserved

10.3.2 I²C Frequency Divider Register (I2CFDR)

The I2CFDR, shown in Figure 10-4, configures the sampling rate and the clock bit rate for the I²C unit.

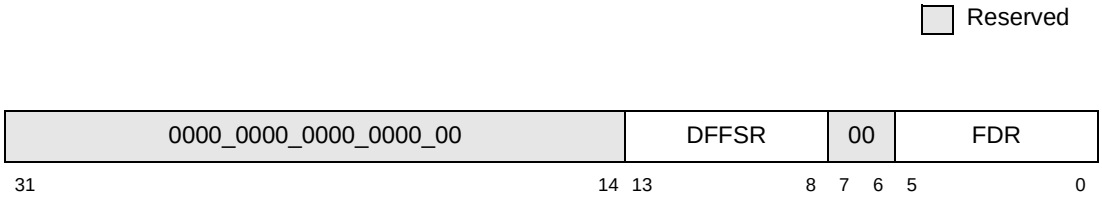


Figure 10-4. I²C Frequency Divider Register (I2CFDR)

Table 10-4 describes the bit settings of the I2CFDR.

Table 10-4. I2CFDR Field Descriptions—Offset 0x0_3004

Bits	Name	Reset Value	R/W	Description
31–14	—	All 0s	R	Reserved
13–8	DFFSR	0x10	R/W	Digital filter frequency sampling rate. To assist in filtering out signal noise, the sample rate is programmable. This field is used to prescale the frequency at which the digital filter takes samples from the I²C bus. The resulting sampling rate is the local memory frequency (SDRAM_CLK) divided by the non-zero value set in this field. If DFFSR is set to zero, the I²C bus sample points default to the reset divisor 0x10.
7–6	—	00	R	Reserved
5–0	FDR	0x00	R/W	Frequency divider ratio. Used to prescale the clock for bit rate selection. The serial bit clock frequency of SCL is equal to the local memory clock (SDRAM_CLK) divided by the divider shown in Table 10-5. Note that the frequency divider value can be changed at any point in a program.

Table 10-5 maps the I2CFDR[FDR] field to the clock divider values.

Table 10-5. Serial Bit Clock Frequency Divider Selections

FDR	Divider (Decimal)	FDR	Divider (Decimal)
0x00	288	0x20	160
0x01	320	0x21	192
0x02	384	0x22	224
0x03	480	0x23	256
0x04	576	0x24	320
0x05	640	0x25	384
0x06	768	0x26	448
0x07	960	0x27	512
0x08	1152	0x28	640
0x09	1280	0x29	768
0x0A	1536	0x2A	896
0x0B	1920	0x2B	1024
0x0C	2304	0x2C	1280
0x0D	2560	0x2D	1536
0x0E	3072	0x2E	1792
0x0F	3840	0x2F	2048
0x10	4608	0x30	2560
0x11	5120	0x31	3072

Table 10-5. Serial Bit Clock Frequency Divider Selections (continued)

FDR	Divider (Decimal)	FDR	Divider (Decimal)
0x12	6144	0x32	3584
0x13	7680	0x33	4096
0x14	9216	0x34	5120
0x15	10240	0x35	6144
0x16	12288	0x36	7168
0x17	15360	0x37	8192
0x18	18432	0x38	10240
0x19	20480	0x39	12288
0x1A	24576	0x3A	14336
0x1B	30720	0x3B	16384
0x1C	36864	0x3C	20480
0x1D	40960	0x3D	24576
0x1E	49152	0x3E	28672
0x1F	61440	0x3F	32768

In some cases, the programmed value for the serial bit clock frequency (SCL) does not match the measured value because of the effect of DFFSR (sampling rate for the digital filter). Both DFFSR and FDR affect the speed of SCL. Six DFFSR intervals (three samples for high and three samples for low) are needed on the SCL to detect the true state of the clock. When the high or low is detected, the FDR value phase (half a cycle) is counted as normal. The frequency that is actually observed is:

$$6 \times \text{DFFSR} + \text{FDR}$$

For instance, if FDR is set to 0x00 (divider = 288 in decimal) and DFFSR is set to 0x30 (divider = 48 in decimal), it takes 3×48 system clocks to detect the high edge. The high level is maintained for an additional 144 clocks to create the first phase of the programmed frequency. It takes 3×48 system clocks to detect a low. The low level is maintained for an additional 144 clocks to create the first phase of the programmed frequency. Thus, the programmed divider is twice the divider shown in the Table 10-5:

$$(6 \times 48) + 288 = 288 + 288 = 576$$

In this case, the frequency is halved because the divider is doubled.

The DFFSR should be reduced to a much smaller value to account for the faster programmed frequency.

10.3.3 I²C Control Register (I2CCR)

Figure 10-5 shows the I2CCR, which controls the modes of the I²C interface, and Table 10-6 describes the bit settings of the I2CCR.

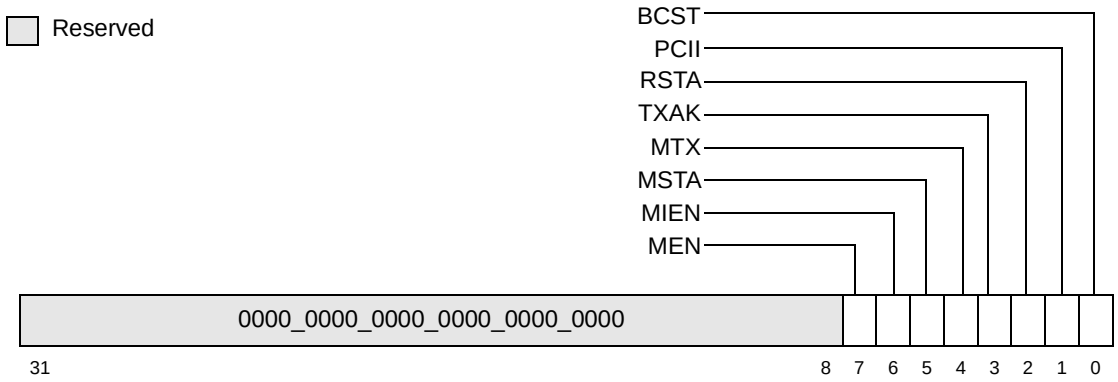


Figure 10-5. I²C Control Register (I2CCR)

Table 10-6. I2CCR Field Descriptions—Offset 0x0_3008

Bits	Name	Reset Value	R/W	Description
31–8	—		R	Reserved
7	MEN	0	R/W	Module enable. This bit controls the software reset of the I²C module. 0 The module is reset and disabled. When low, the interface is held in reset. In this state, all the registers except I2CDR can still be accessed. 1 The I²C module is enabled. This bit must be set before any other control register bits have any effect. All I²C registers for slave receive or master START can be initialized before setting this bit. Refer to Section 10.2.5, “Arbitration Procedure.”
6	MIEN	0	R/W	Module interrupt enable 0 Interrupts from the I²C module are disabled. This setting does not clear any pending interrupt conditions. 1 Interrupts from the I²C module are enabled. When an interrupt condition occurs, an interrupt (*int*) is generated, provided I2CSR[MIF] is also set.
5	MSTA	0	R/W	Master/slave mode START 0 Slave mode. When this bit is changed from a 1 to 0, a STOP condition is generated and the mode changes from master to slave. 1 Master mode. When this bit is changed from a 0 to 1, a START condition is generated on the bus, and the master mode is selected. The MSTA bit is cleared without generating a STOP condition when the master loses arbitration. See Section 10.2.5, “Arbitration Procedure.”
4	MTX	0	R/W	Transmit/receive mode select. This bit selects the direction of the master and slave transfers. When configured as a slave, this bit should be set by software according to I2CSR[SRW]. In master mode, the bit should be set according to the type of transfer required. Therefore, for address cycles, this bit is always high. 0 Receive mode 1 Transmit mode The MTX bit is cleared when the master loses arbitration.

Table 10-6. I2CCR Field Descriptions—Offset 0x0_3008 (continued)

Bits	Name	Reset Value	R/W	Description
3	TXAK	0	R/W	Transfer acknowledge. This bit specifies the value driven onto the SDA line during acknowledge cycles for both master and slave receivers. The value of this bit applies only when the I²C module is configured as a receiver, not a transmitter, and does not apply to address cycles. When the MPC8245 is addressed as a slave, an acknowledge is always sent. 0 An acknowledge signal (low value on SDA) is sent out to the bus at the 9th clock bit after receiving one byte of data. 1 No acknowledge signal response is sent (that is, acknowledge value on SDA is high).
2	RSTA	0	W	Repeat START. Setting this bit causes a repeated START condition to be always generated on the bus, provided the MPC8245 is the current bus master. Attempting a repeated START at the wrong time (or if the bus is owned by another master) causes a loss of arbitration. Note that this bit is not readable. 0 No repeat START condition 1 Generates repeat START condition
1	PCII	0	R/W	PCI interrupt enable. This bit directs an interrupt to either the local processor bus (through PIC) or the PCI bus $\overline{\text{INTA}}$ pin. 0 All interrupts go to the local processor if MIEN and MIF are set. 1 All interrupts go to the PCI bus if MIEN and MIF are set.
0	BCST	0	R/W	Broadcast enable. This bit allows broadcast messages to be acknowledged. 0 Do not acknowledge broadcast address of all zeros 1 If a broadcast address of all zeros is detected, acknowledge address I2CSR[MIF] bit is set. Note that the second byte of the broadcast message is the master device ID. Because the second byte is automatically acknowledged by hardware, the receiver device software must verify that the broadcast message is intended for itself by reading the second byte of the message. If the device ID is for another receiver device and the third byte is a write command, then software can ignore the third byte during the broadcast. If the device ID is for another receiver device and the third byte is a read command, software must write 0xFF to the I2CDR with I2CCR[TXAK] = 1 so that it does not interfere with the data written from the addressed device.

10.3.4 I²C Status Register (I2CSR)

The status register (see Figure 10-6), is read-only with the exception of the MIF and MAL bits, which software can clear. The MCF and RXAK bits are set at reset, and resetting clears all other I2CSR bits.

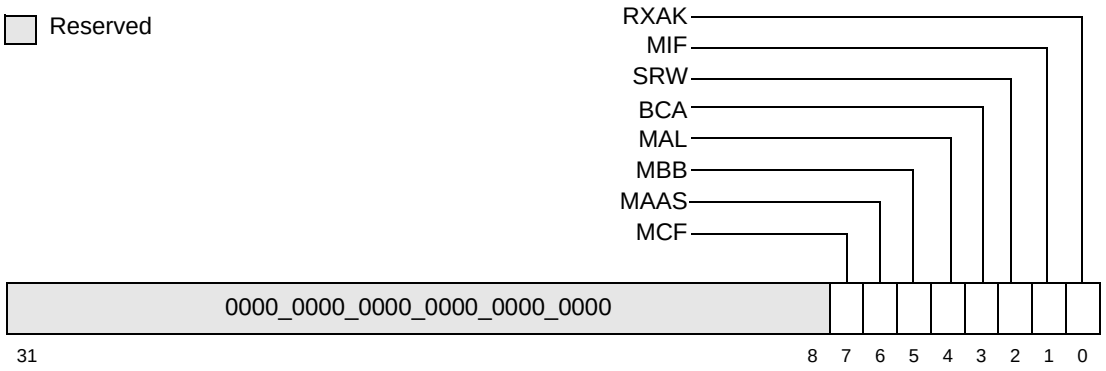


Figure 10-6. I²C Status Register (I2CSR)

Table 10-7 describes the bit settings of the I2CSR.

Table 10-7. I2CSR Field Descriptions—Offset 0x0_300C

Bits	Name	Reset Value	R/W	Description
31–8	—	0	R	Reserved
7	MCF	1	R	Data transferring. While one byte of data is being transferred, this bit is cleared. It is set by the falling edge of the 9th clock of a byte transfer. 0 Transfer in progress. MCF is cleared when I2CDR is read in receive mode or when I2CDR is written in transmit mode. 1 Transfer complete
6	MAAS	0	R	Addressed as a slave. When the value in I2CADR matches the calling address, this bit is set. The processor is interrupted (by the *int* signal through PIC), provided I2CCR[MIEN] is set. Next, the processor must check the SRW bit and set I2CCR[MTX] accordingly. Writing to the I2CCR automatically clears this bit. 0 Not addressed as a slave 1 Addressed as a slave
5	MBB	0	R	Bus busy. This bit indicates the status of the bus. When a START condition is detected, MBB is set. If a STOP condition is detected, it is cleared. 0 I²C bus is idle. 1 I²C bus is busy.
4	MAL	0	R/W	Arbitration lost. This bit is automatically set when the arbitration procedure is lost. Note that the MPC8245 does not automatically retry a failed transfer attempt. 0 Arbitration is not lost. Can only be cleared by software. 1 Arbitration is lost. See Section 10.2.5, “Arbitration Procedure.”

Table 10-7. I2CSR Field Descriptions—Offset 0x0_300C (continued)

Bits	Name	Reset Value	R/W	Description
3	BCA	0	R	Broadcast address detection. When I2CCR[BCST] bit is set, this bit indicates if a broadcast address has been accepted. 1 A broadcast message of all zeros has been detected and hardware has asserted an interrupt (set I2CSR[MIF] bit). The broadcast feature is software driven. There is no hardware decode of the data bytes that follow the broadcast address. An interrupt is generated as in the case of a normal data byte received as a slave.
2	SRW	0	R	Slave read/write. When MAAS is set, SRW indicates the value of the R/$\overline{W}$ command bit of the calling address sent from the master. 0 Slave receive, master writing to slave 1 Slave transmit, master reading from slave This bit is valid only when both of the following occur: • A complete transfer has occurred and no other transfers have been initiated. • The I²C interface is configured as a slave and has an address match. By checking this bit, the processor can select slave transmit/receive mode according to the command of the master.
1	MIF	0	R/W	Module interrupt. The MIF bit is set when an interrupt is pending, causing a processor interrupt request (provided I2CCR[MIEN] is set). 0 No interrupt pending. Can only be cleared by software. 1 Interrupt pending. MIF is set when one of the following occurs: • One byte of data is transferred (set at the falling edge of the 9th clock) • The value in I2CADR matches the calling address in slave-receive mode • Arbitration is lost. See Section 10.2.5, “Arbitration Procedure.” • Receive a broadcast (general calling) address of all zeros when I2CCR[BCST] is set
0	RXAK	1	R	Received acknowledge. The value of SDA during the acknowledge bit of a bus cycle. If the received acknowledge bit (RXAK) is low, it indicates that an acknowledge signal has been received after the completion of eight bits of data transmission on the bus. If RXAK is high, it means no acknowledge signal has been detected at the 9th clock. 0 Acknowledge received 1 No acknowledge received

10.3.5 I²C Data Register (I2CDR)

In master mode, bits 7-1, I2CDR[DATA] comprise the destination slave address.þ Bit 0 indicates the direction of transfer (0 represents master transmission and 1 represents master reception).

Figure 10-7 shows the data register.

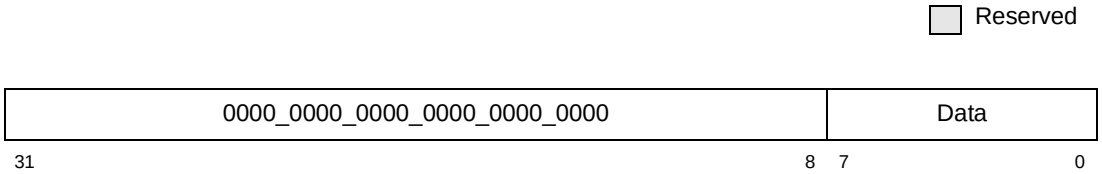


Figure 10-7. I²C Data Register (I2CDR)

Table 10-8 describes I2CDR.

Table 10-8. I2CDR Field Descriptions—Offset 0x0_3010

Bits	Name	Reset Value	R/W	Description
31–8	—		R	Reserved
7–0	DATA	0x00	R/W	Transmission starts when a 7-bit address is written to bits 7–1 of this field, the R/$\overline{W}$ bit (I2CCR[MTX]) is set, and the I^2C interface is the master. A data transfer is initiated when data is written to the I2CDR. The most significant bit (msb) is sent first in both cases. In the master receive mode, reading the data register allows the read to occur but also initiates next byte data receiving. In slave mode, the same function is available after it is addressed.

10.4 Programming Guidelines

This section describes some programming guidelines recommended for the I^2C interface on the MPC8245 and provides a recommended flowchart for the I^2C interrupt service routines.

The I^2C registers in this chapter are shown in little-endian format. If the system is in big-endian mode, software must swap the bytes appropriately. Also, to guarantee in-order execution, a **sync** assembly instruction should be executed after each I^2C register read/write access.

The MPC8245 does not guarantee a recovery from all illegal I^2C bus activity. Furthermore, a malfunctioning device might hold the bus captive. A good programming practice is for software to rely on a watchdog timer to help recover from I^2C bus hangs. The recovery routine should also handle the case when the status bits returned after an interrupt are not consistent with what was expected due to illegal I^2C bus protocol behavior.

Example I^2C code can be found in the MPC8245 Device Driver Toolbox available through the Motorola web site: http://www.motorola.com/semiconductors.

10.4.1 Initialization Sequence

A hard reset initializes all the I^2C registers to their default states. The following initialization sequence initializes the I^2C unit:

1. If the processor's memory management unit (MMU) is enabled, all I^2C registers must be located in a cache-inhibited area.
2. Program the embedded utilities memory block (see Section 3.4, "Embedded Utilities Memory Block (EUMB)").
3. Update I2CFDR and select the required division ratio to obtain the SCL frequency from the local memory clock (SDRAM_CLK).
4. Update the I2CADR to define the slave address for this device.

5. Modify I2CCR to select master/slave mode, transmit/receive mode, and interrupt-enable or disable.
6. Set the I2CCR[MEN] to enable the I^2C interface.

10.4.2 Generation of START

After initialization, use the following sequence to generate START:

1. If the MPC8245 is connected to a multimaster I^2C system, test the state of I2CSR[MBB] to check whether the serial bus is free (I2CSR[MBB] = 0) before switching to master mode.
2. Select master mode (set I2CCR[MSTA]) to transmit serial data.
3. Write the slave address being called into the data register (I2CDR). The data written to I2CDR[7–1] comprises the slave calling address. I2CDR[0] indicates the direction of transfer (0 indicates transmit/1 indicates receive) required from the slave.
4. Set I2CCR[MTX] for the address cycle.

The above scenario assumes the I^2C interrupt bit (I2CSR[MIF]) is cleared. If I2CSR[MIF] = 1 at any time, the I^2C interrupt handler should immediately handle the interrupt. See Section 10.4.8, “Interrupt Service Routine Flowchart.”

10.4.3 Post-Transfer Software Response

Transmission or reception of a byte automatically sets the data transferring bit (I2CSR[MCF]), which indicates that one byte has been transferred. The I^2C interrupt bit (I2CSR[MIF]) is also set; an interrupt is generated to the processor if the interrupt function is enabled during the initialization sequence (I2CCR[MIEN] = 1). In the interrupt handler, software must do the following:

- Clear I2CSR[MIF]
- Read the contents of the I^2C data register (I2CDR) in receive mode or write to I2CDR in transmit mode. Note that this causes I2CSR[MCF] to be cleared. See Section 10.4.8, “Interrupt Service Routine Flowchart.”

When an interrupt occurs at the end of the address cycle, the master remains in transmit mode. If master receive mode is required, I2CCR[MTX] should be toggled at this stage. See Section 10.4.8, “Interrupt Service Routine Flowchart.”

If the interrupt function is disabled, software can service the I2CDR in the main program by monitoring I2CSR[MIF]. In this case, I2CSR[MIF] should be polled rather than I2CSR[MCF] because MCF behaves differently when arbitration is lost. Note that interrupt or other bus conditions may be detected by the MPC8245 before the I^2C signals have time

to settle. Thus, when polling I2CSR[MIF] (or any other I2SCR bits), software delays may be needed (in order to give the I^2C signals sufficient time to settle).

During slave-mode address cycles (I2CSR[MAAS] = 1), I2CSR[SRW] should be read to determine the direction of the subsequent transfer and I2CCR[MTX] should be programmed accordingly. For slave-mode data cycles (I2CSR[MAAS] = 0), I2CSR[SRW] is not valid and I2CCR[MTX] should be read to determine the direction of the current transfer. See Section 10.4.8, “Interrupt Service Routine Flowchart,” for more details.

10.4.4 Generation of STOP

A data transfer ends with a STOP condition that the master device generated. A master transmitter can generate a STOP condition after all the data is transmitted.

If a master receiver wants to terminate a data transfer, it must inform the slave transmitter by not acknowledging the last byte of data (setting the transmit acknowledge (I2CCR[TXAK]) bit before reading the next-to-last byte of data). For one-byte transfers, the interrupt service routine should perform a dummy read. (See Section 10.4.8, “Interrupt Service Routine Flowchart.”) Before the interrupt service routine reads the last byte of data, the MPC8245 must generate a STOP condition first.

The MPC8245 automatically generates a STOP if I2CCR[TXAK] = 1. Therefore, I2CCR[TXAK] must be set to a 1 before allowing the MPC8245 to receive the last data byte on the I^2C bus.

10.4.5 Generation of Repeated START

At the end of a data transfer, if the master still wants to communicate on the bus, it can generate another START condition followed by another slave address without first generating a STOP condition by setting I2CCR[RSTA].

10.4.6 Generation of SCK when SDA Low

In some cases it is necessary to force the MPC8245 to become the I^2C bus master out of reset and drive the SCK signal (even though SDA may already be driven, which indicates that the bus is busy). This situation can occur when a system reset does not cause all I^2C devices to be reset. The SDA signal can be driven low by another I^2C device while the MPC8245 is coming out of reset and stays low indefinitely. To force the MPC8245 to generate SCK so that the device driving SDA can finish its transaction, use the following procedure on the MPC8245:

1. Disable the I^2C and set the master bit by setting I2CCR to 0x20.
2. Enable the I^2C by setting I2CCR to 0xA0.
3. Read the I2CDR.

4. Return the MPC8245 to slave mode by setting I2CCR to 0x80.

10.4.7 Slave Mode Interrupt Service Routine

In the slave interrupt service routine, the module addressed as a slave should be tested to check if a calling of its own address has just been received. If I2CSR[MAAS] = 1, software should set the transmit/receive mode select bit (I2CCR[MTX]) according to the R/$\overline{W}$ command bit (I2CSR[SRW]). Writing to I2CCR clears I2CSR[MAAS] automatically. The only time I2CSR[MAAS] is read as set is from the interrupt handler at the end of that address cycle where an address match occurred; interrupts resulting from subsequent data transfers have I2CSR[MAAS] = 0. A data transfer can then be initiated by writing to I2CDR for slave transmits or dummy reading from I2CDR in slave-receive mode. The slave drives SCL low between byte transfers. SCL is released when the I2CDR is accessed in the required mode.

10.4.7.1 Slave Transmitter and Received Acknowledge

In the slave transmitter routine, the received acknowledge bit (I2CSR[RXAK]) must be tested before sending the next byte of data. The master signals an end-of-data by not acknowledging the data transfer from the slave. When no acknowledge is received (I2CSR[RXAK] = 1), the slave transmitter interrupt routine must clear I2CCR[MTX] to switch the slave from transmitter to receiver mode. A dummy read of I2CDR then releases SCL so that the master can generate a STOP condition. See Section 10.4.8, “Interrupt Service Routine Flowchart.”

10.4.7.2 Loss of Arbitration and Forcing of Slave Mode

When a master loses arbitration (see Section 10.2.5, “Arbitration Procedure”), I2CSR[MAL] is set, which indicates loss of arbitration, I2CCR[MSTA] is cleared (changing the master to slave mode), and an interrupt occurs (if enabled) at the falling edge of the 9th clock of this transfer. Thus, the slave interrupt service routine should test I2CSR[MAL] first, and the software should clear I2CSR[MAL] if it is set.

10.4.8 Interrupt Service Routine Flowchart

Figure 10-8 shows an example algorithm for an I^2C interrupt service routine. Deviation from the flowchart may result in unpredictable I^2C bus behavior except that unlike what is shown in the flowchart, in slave receive mode, the interrupt service routine may need to set I2CCR[TXAK] when the next-to-last byte is to be accepted. Motorola recommends that a **sync** instruction should follow each I^2C register read or write to guarantee in-order instruction execution.

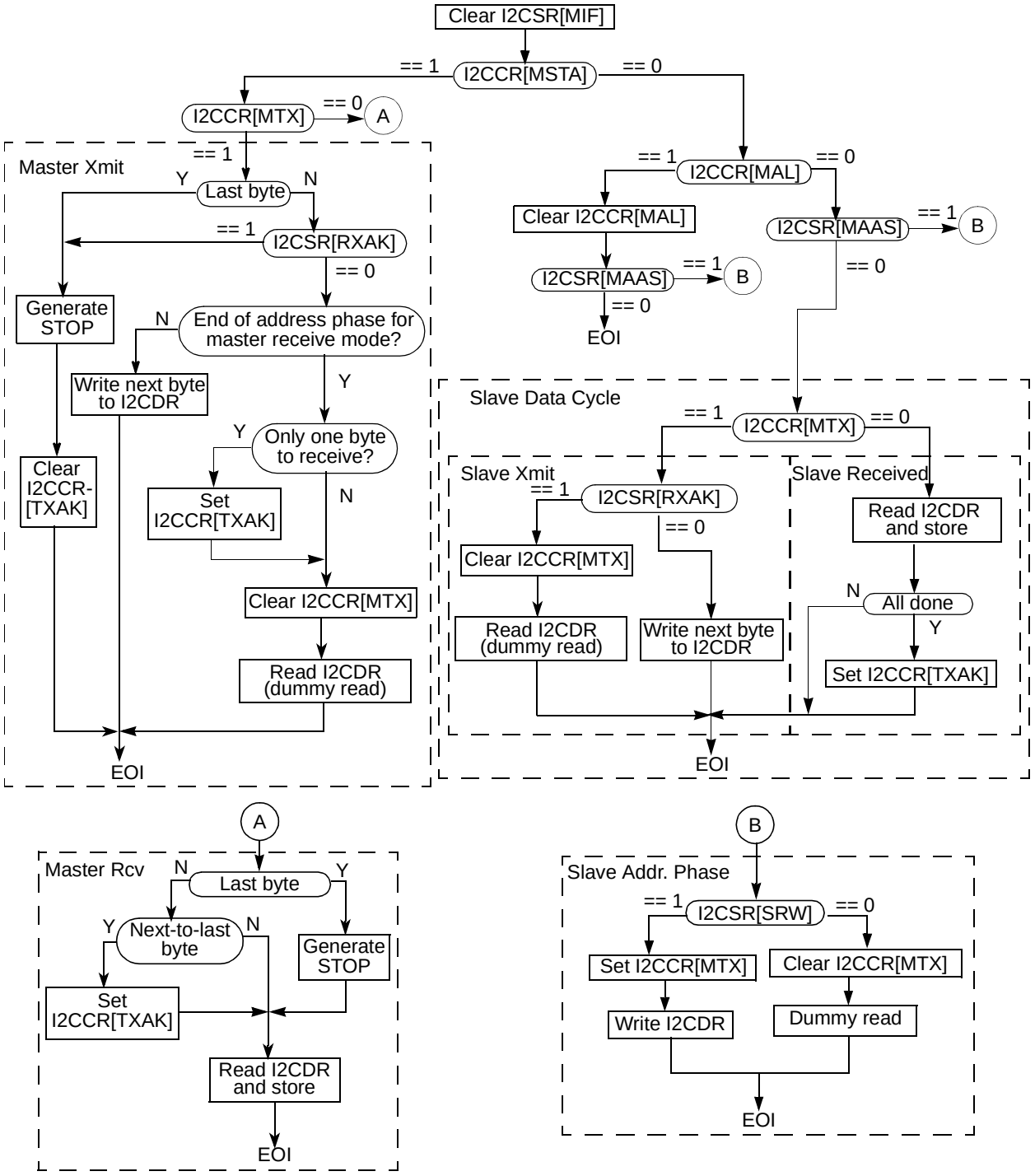


Figure 10-8. Example I²C Interrupt Service Routine Flowchart

Chapter 11
Programmable Interrupt Controller (PIC) Unit

This chapter describes the following:

- Programmable interrupt controller (PIC) interrupt protocol
- Various types of interrupt sources that the PIC unit controls
- PIC registers with some programming guidelines

The interrupt sources and soft reset controlled by the PIC unit, *sreset*, and the internal *mcp* which is generated by the MPC8245 central control unit (CCU) all cause exceptions in the processor core. The *int* signa, the main interrupt output from the PIC to the processor core, causes the external interrupt exception. The external SRESET signal or the internal *sreset* output of the PIC unit causes the soft reset processor exception. The machine check exception is caused by the internal *mcp* signal that the CCU generates, to inform the processor of error conditions, assertion of the external NMI signal, and other conditions. See Chapter 14, “Error Handling,” for further information about the sources of the internal *mcp* signal.

11.1 PIC Unit Overview

The PIC unit implements the necessary functions for providing a flexible and general-purpose interrupt controller solution. The PIC pools hardware-generated interrupts from many sources, both within the MPC8245 and externally, and delivers them to the processor core in a prioritized manner. Note that the messaging unit (MU), rather than the PIC unit. manages assertion of the INTA signal to the PCI bus.

The PIC solution adopts the OpenPIC architecture (developed jointly by AMD and Cyrix for SMP interrupt solutions) and implements the logic and programming structures according to that specification. The MPC8245 PIC unit supports up to five external interrupts or one serial-style interrupt line (supporting 16 interrupts) and a pass-through mode. Additionally, the PIC unit supports six internal logic-driven interrupts and four timers with interrupts. The following sections give an overview of the features of the PIC unit and a complete summary of the signals used by the PIC unit.

11.1.1 PIC Features Summary

The MPC8245 PIC unit implements the following features:

- OpenPIC programming model
- Support for five external discrete interrupt sources or one serial-style interrupt (16 interrupt sources)
- Four global, cascadable, high-resolution timers that can be interrupt sources
- Interrupt control for the MPC8245 I^2C unit, DUART unit, DMA unit (two channels), and message unit (MU)
- Support for connection of external interrupt controller device such as an 8259 Programmable Interrupt Controller (PIC)
- Generation of local (internal) interrupts output signal, $\overline{\text{L_INT}}$, in 8259 (pass-through) mode
- Processor initialization control—Software can reset the processor with the processor initialization register.
- Programmable resetting of the PIC unit through the global configuration register
- 16 programmable interrupt priority levels
- Fully nested interrupt delivery
- Spurious vector generation
- 32-bit configuration registers that are aligned on 128-bit boundaries

11.1.2 PIC Interface Signal Description

In addition to the $\overline{int}$ signal, Table 11-1 defines external PIC signals.

Table 11-1. PIC Interface Signal Description

Signal Name	Pins	I/O	State Meaning
IRQ0/S_INT	1	I	Direct IRQ mode—Input representing an incoming interrupt request Serial IRQ mode—Input representing the serial interrupt data stream Note that the IRQ0 is used when operating in the pass-through mode.
IRQ1/S_CLK	1	I/O	Direct IRQ mode—Input representing an incoming interrupt request Serial IRQ mode—Output representing the serial clock by which the remote sequencer (interrupt source) clocks serial interrupts out
IRQ2/S_RST	1	I/O	Direct IRQ mode—Input representing an incoming interrupt request Serial IRQ mode—Output pulse is high after PIC resets and is set to serial mode. It determines the serial interrupt slot count for all external serial devices. Refer to Figure 11-1.

Table 11-1. PIC Interface Signal Description (continued)

Signal Name	Pins	I/O	State Meaning
IRQ3/S_FRAME	1	I/O	Direct IRQ mode—Input representing an incoming interrupt request Serial IRQ mode—Output that pulses low each time the interrupt controller is sampling interrupt source 0
IRQ4/L_INT	1	I/O	Direct IRQ mode—Input representing an incoming interrupt request Serial IRQ mode—Not used Pass-through mode—Output goes low whenever there is an interrupt from the MPC8245 internal DMA0, DMA1, MU, DUART or I^2C units.

11.1.3 PIC Block Diagram

The PIC unit in the MPC8245 is accessible from the processor only. The processor reads and writes the memory-mapped PIC configuration and status registers.

Figure 11-1 shows the block diagram of the PIC unit and its relationship to the processor core and external signals.

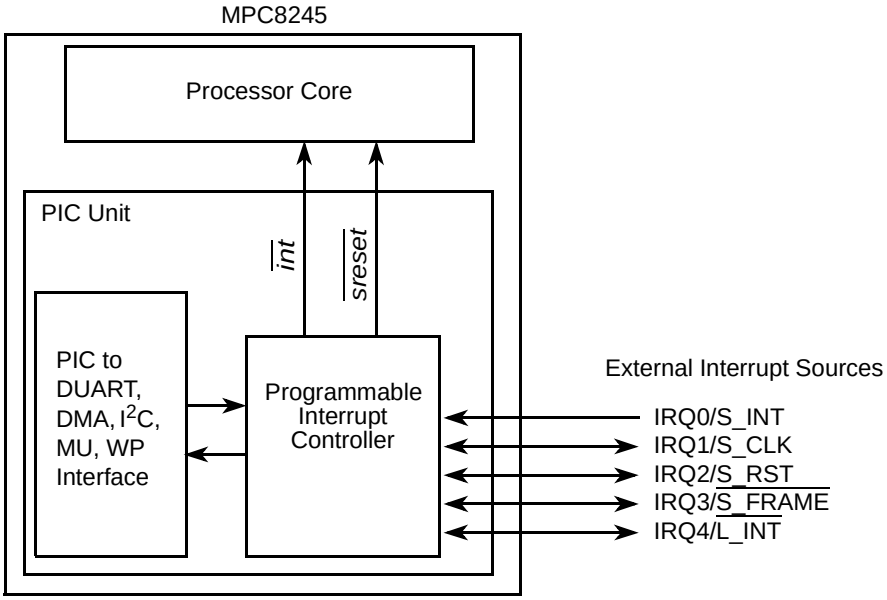


Figure 11-1. PIC Unit Block Diagram

11.2 PIC Register Summary

The PIC register map occupies a 256-Kbyte range of the embedded utilities memory block (EUMB). For further details, see Section 3.4, “Embedded Utilities Memory Block (EUMB).” If an access is attempted to an undefined portion of the map, the device returns 0x0000_0000 as its value on reads and does nothing on writes.

All PIC registers are 32 bits wide and reside on 16-byte address boundaries. All addresses mentioned in this chapter are offsets from the EUMBBAR located at 0x78; see Section 4.5, “Embedded Utilities Memory Block Base Address Register—0x78.”

The PIC address offset map is divided into the following four distinct areas:

- 0xnnn4_1000 – 0xnnn4_01F0—Global PIC register map
- 0xnnn4_1100 – 0xnnn5_01F0—Global timer register map
- 0xnnn5_0200 – 0xnnn5_FFF0—Interrupt source configuration register map
- 0xnnn6_0000 – 0xnnn6_3FF0—Processor-related register map

Table 11-2 defines the address map for the global PIC and timer registers. See Section 11.9, “Register Definitions,” for detailed register and field descriptions.

Table 11-2. PIC Register Address Map—Global and Timer Registers

Address Offset from EUMBBAR	Register Name	Field Mnemonics
0x4_1000	Feature reporting register (FRR)	NIRQ, NCPU, VID
0x4_1010	Reserved	—
0x4_1020	Global configuration register (GCR)	R (reset), M (mode)
0x4_1030	PIC interrupt configuration register (ICR)	R (clock ratio), SIE
0x4_1040–0x4_1070	Reserved	—
0x4_1080	Interrupt controller vendor identification register (IVI)	STEP, DEVICE_ID, VENDOR_ID
0x4_1090	Processor initialization register (PI)	P0
0x4_10A0–0x4_10D0	Reserved	—
0x4_10E0	Spurious vector register (SVR)	VECTOR
0x4_10F0	Timer frequency reporting register (TFRR)	TIMER_FREQ
0x4_10F4	Timer control register (TCR)	TC (timer cascade)
0x4_1100	Global timer 0 current count register (GTCCR0)	T (toggle), COUNT
0x4_1110	Global timer 0 base count register (GTBCR0)	CI, BASE_COUNT
0x4_1120	Global timer 0 vector/priority register (GTVPR0)	M, A, PRIORITY, VECTOR
0x4_1130	Global timer 0 destination register (GTDR0)	P0
0x4_1140	Global timer 1 current count register (GTCCR1)	T (toggle), COUNT
0x4_1150	Global timer 1 base count register (GTBCR1)	CI, BASE_COUNT
0x4_1160	Global timer 1 vector/priority register (GTVPR1)	M, A, PRIORITY, VECTOR
0x4_1170	Global timer 1 destination register (GTDR1)	P0
0x4_1180	Global timer 2 current count register (GTCCR2)	T (toggle), COUNT
0x4_1190	Global timer 2 base count register (GTBCR2)	CI, BASE_COUNT
0x4_11A0	Global timer 2 vector/priority register (GTVPR2)	M, A, PRIORITY, VECTOR

Table 11-2. PIC Register Address Map—Global and Timer Registers (continued)

Address Offset from EUMBBAR	Register Name	Field Mnemonics
0x4_11B0	Global timer 2 destination register (GTDR2)	P0
0x4_11C0	Global timer 3 current count register (GTCCR3)	T (toggle), COUNT
0x4_11D0	Global timer 3 base count register (GTBCR3)	CI, BASE_COUNT
0x4_11E0	Global timer 3 vector/priority register (GTVPR3)	M, A, PRIORITY, VECTOR
0x4_11F0	Global timer 3 destination register (GTDR3)	P0
0x4_1200–0x5_01F0	Reserved	—

Table 11-3 defines the address map for the interrupt source configuration registers. Note that the address space 0x5_0200 through 0x5_0290 maps to the direct or the serial interrupt registers, depending on the setting of ICR[SIE].

Table 11-3. PIC Register Address Map—Interrupt Source Configuration Registers

Address Offset from EUMBBAR	Register Name	Field Mnemonics
0x5_0200	IRQ0 vector/priority register (IVPR0)	M, A, P, S, PRIORITY, VECTOR
0x5_0210	IRQ0 destination register (IDR0)	P0
0x5_0220	IRQ1 vector/priority register (IVPR1)	M, A, P, S, PRIORITY, VECTOR
0x5_0230	IRQ1 destination (IDR1)	P0
0x5_0240	IRQ2 vector/priority register (IVPR2)	M, A, P, S, PRIORITY, VECTOR
0x5_0250	IRQ2 destination (IDR2)	P0
0x5_0260	IRQ3 vector/priority register (IVPR3)	M, A, P, S, PRIORITY, VECTOR
0x5_0270	IRQ3 destination (IDR3)	P0
0x5_0280	IRQ4 vector/priority register (IVPR4)	M, A, P, S, PRIORITY, VECTOR
0x5_0290	IRQ4 destination (IDR4)	P0
0x5_0200	Serial interrupt 0 vector/priority register (SVPR0)	M, A, P, S, PRIORITY, VECTOR
0x5_0210	Serial interrupt 0 destination register (SIR0)	P0
0x5_0220	Serial interrupt 1 vector/priority register (SVPR1)	M, A, P, S, PRIORITY, VECTOR
0x5_0230	Serial interrupt 1 destination register (SIR1)	P0
0x5_0240	Serial interrupt 2 vector/priority register (SVPR2)	M, A, P, S, PRIORITY, VECTOR
0x5_0250	Serial interrupt 2 destination register (SIR2)	P0
0x5_0260	Serial interrupt 3 vector/priority register (SVPR3)	M, A, P, S, PRIORITY, VECTOR
0x5_0270	Serial interrupt 3 destination register (SIR3)	P0
0x5_0280	Serial interrupt 4 vector/priority register (SVPR4)	M, A, P, S, PRIORITY, VECTOR
0x5_0290	Serial interrupt 4 destination register (SIR4)	P0

Table 11-3. PIC Register Address Map—Interrupt Source Configuration Registers

Address Offset from EUMBBAR	Register Name	Field Mnemonics
0x5_02A0	Serial interrupt 5 vector/priority register (SVPR5)	M, A, P, S, PRIORITY, VECTOR
0x5_02B0	Serial interrupt 5 destination register (SIR5)	P0
0x5_02C0	Serial interrupt 6 vector/priority register (SVPR6)	M, A, P, S, PRIORITY, VECTOR
0x5_02D0	Serial interrupt 6 destination register (SIR6)	P0
0x5_02E0	Serial interrupt 7 vector/priority register (SVPR7)	M, A, P, S, PRIORITY, VECTOR
0x5_02F0	Serial interrupt 7 destination register (SIR7)	P0
0x5_0300	Serial interrupt 8 vector/priority register (SVPR8)	M, A, P, S, PRIORITY, VECTOR
0x5_0310	Serial interrupt 8 destination register (SIR8)	P0
0x5_0320	Serial interrupt 9 vector/priority register (SVPR9)	M, A, P, S, PRIORITY, VECTOR
0x5_0330	Serial interrupt 9 destination register (SIR9)	P0
0x5_0340	Serial interrupt 10 vector/priority register (SVPR10)	M, A, P, S, PRIORITY, VECTOR
0x5_0350	Serial interrupt 10 destination register (SIR10)	P0
0x5_0360	Serial interrupt 11 vector/priority register (SVPR11)	M, A, P, S, PRIORITY, VECTOR
0x5_0370	Serial interrupt 11 destination register (SIR11)	P0
0x5_0380	Serial interrupt 12 vector/priority register (SVPR12)	M, A, P, S, PRIORITY, VECTOR
0x5_0390	Serial interrupt 12 destination register (SIR12)	P0
0x5_03A0	Serial interrupt 13 vector/priority register (SVPR13)	M, A, P, S, PRIORITY, VECTOR
0x5_03B0	Serial interrupt 13 destination register (SIR13)	P0
0x5_03C0	Serial interrupt 14 vector/priority register (SVPR14)	M, A, P, S, PRIORITY, VECTOR
0x5_03D0	Serial interrupt 14 destination register (SIR14)	P0
0x5_03E0	Serial interrupt 15 vector/priority register (SVPR15)	M, A, P, S, PRIORITY, VECTOR
0x5_03F0	Serial interrupt 15 destination register (SIR15)	P0
0x5_0400–0x5_1010	Reserved	—
0x5_1020	I^2C interrupt vector/priority register (IIVPR0)	M, A, PRIORITY, VECTOR
0x5_1030	I^2C interrupt destination register (IIDR0)	P0
0x5_1040	DMA Ch0 interrupt vector/priority register (IIVPR1)	M, A, PRIORITY, VECTOR
0x5_1050	DMA Ch0 interrupt destination register (IIDR1)	P0
0x5_1060	DMA Ch1 interrupt vector/priority register (IIVPR2)	M, A, PRIORITY, VECTOR
0x5_1070	DMA Ch1 interrupt destination register (IIDR2)	P0
0x5_1080–0x5_10B0	Reserved	—
0x5_10C0	Message unit interrupt vector/priority register (IIVPR3)	M, A, PRIORITY, VECTOR
0x5_10D0	Message unit interrupt destination register (IIDR3)	P0
0x5_10E0–0x5_1110	Reserved	—

Table 11-3. PIC Register Address Map—Interrupt Source Configuration Registers

Address Offset from EUMBBAR	Register Name	Field Mnemonics
0x5_1120	DUART Ch1 interrupt vector/priority register (IIVPR4)	M, A, P, S, PRIORITY, VECTOR
0x5_1130	DUART Ch1 interrupt destination register (IIDR4)	P0
0x5_1140	DUART Ch2 interrupt vector/priority register (IIVPR5)	M, A, P, S, PRIORITY, VECTOR
0x5_1150	DUART Ch2 interrupt destination register (IIDR5)	P0
0x5_1160–0x5_FFF0	Reserved	—

Table 11-4 defines the address map for the processor-related registers.

Table 11-4. PIC Register Address Map—Processor-Related Registers

Address Offset from EUMBBAR	Register Name	Field Mnemonics
0x6_0000–0x6_0070	Reserved	—
0x6_0080	Processor current task priority register (PCTPR)	TASKP
0x6_0090	Reserved	—
0x6_00A0	Processor interrupt acknowledge register (IACK)	VECTOR
0x6_00B0	Processor end-of-interrupt register (EOI)	EOI_CODE
0x6_00C0–0x6_3FF0	Reserved	—

11.3 PIC Unit Interrupt Protocol

The following sections describe the priority of interrupts that the following control:

- PIC unit
- Interrupt acknowledge mechanism
- Nesting of multiple interrupts
- Handling of spurious interrupts

11.3.1 Interrupt Source Priority

The software assigns a priority value to each interrupt source by writing to the vector/priority register for the particular source. Priority values are in the range 0 to 15 (15 is the highest). To signal an interrupt to the processor, the priority of the source must be greater than that of the current task priority of the processor (and the in-service interrupt source priority). Therefore, setting a source priority to zero inhibits that interrupt.

The PIC unit services simultaneous interrupts occurring with the same priority according to the following set order: timer 0–timer 3, DMA0, DMA1, MU, I^2C, UART1, UART2, direct interrupts from IRQ[0:4](or serial interrupt source).

11.3.2 Processor Current Task Priority

The PIC unit's processor current task priority register (PCTPR) is set by system software to indicate the relative importance of the task running on the processor. When an interrupt has a priority level greater than the current task priority (and the in-service interrupt source priority), it is signaled to the processor. Setting the task priority to 15 in the PCTPR prevents the signaling of any interrupt to the processor core from the PIC unit.

11.3.3 Interrupt Acknowledge

The PIC unit notifies the processor core of an interrupt by asserting the $\overline{int}$ signal. When the processor acknowledges the interrupt request by reading the interrupt acknowledge register (IACK) in PIC unit, the PIC returns the 8-bit interrupt vector associated with the interrupt source to the processor through the internal data bus. The interrupt is then considered to be in service, and it remains so until the processor performs a write to the PIC unit end of interrupt (EOI) register. Writing to the EOI register is called an *EOI cycle*.

11.3.4 Nesting of Interrupts

If the processor core is servicing an interrupt, it can be interrupted again only if the PIC unit receives an interrupt request from an interrupt source with a priority level greater than the current task priority (and the in-service interrupt source priority) and if MSR[EE] = 1.

Although several interrupts may be in service simultaneously in the processor, the currently executing code always handles the highest priority interrupt of the interrupts in service. When the processor performs an EOI cycle, this highest priority interrupt is taken out of service. The next EOI cycle takes the next highest priority interrupt out of service, and so on.

11.3.5 Spurious Vector Generation

Under certain circumstances, the PIC may not have a valid vector to return to the processor during an interrupt acknowledge cycle (for example, if a pending interrupt does not have a sufficient priority level). In these cases, the spurious vector from the spurious vector register is returned. The following cases cause a spurious vector fetch:

- $\overline{int}$ is asserted in response to an externally sourced interrupt that is activated with level-sensitive logic, and the asserted level is negated before the interrupt is acknowledged.
- $\overline{int}$ is asserted for an interrupt source that is later masked by the setting of the mask bit in the vector/priority register before the interrupt is acknowledged.
- $\overline{int}$ is asserted for an interrupt source that is later masked by an increase in the task priority level before the interrupt is acknowledged.

- $\overline{int}$ is not asserted (that is, a programming error causes software to read the IACK with no interrupt pending).
- $\overline{int}$ is asserted when an illegal clock ratio value is in the PIC interrupt configuration register.

When a spurious interrupt occurs, the interrupt handler should not write to the EOI register. Otherwise, a previously accepted interrupt might be cleared unintentionally.

11.3.6 Internal Block Diagram Description

Figure 11-2 shows the interaction of the non-programmable PIC registers and interrupt delivery logic (assertion of the $\overline{int}$ signal to the processor).

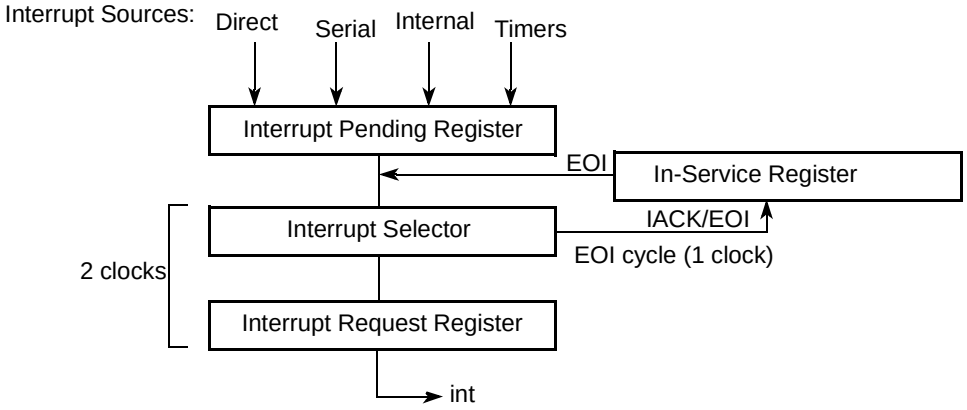


Figure 11-2. PIC Interrupt Generation Block Diagram—Nonprogrammable Registers

11.3.6.1 Interrupt Pending Register (IPR)—Nonprogrammable

The interrupt signals in the PIC unit are qualified and synchronized by the internal IPR, which has one bit for each interrupt. The mask bits from the appropriate vector/priority register qualify the output of the IPR. If an interrupt condition is detected when the mask bit is set, that interrupt is not requested until the mask bit is cleared.

The interrupt sources are internal (DUART, I^2C, DMA, or MU), PIC (four timers), and external (5 direct or 16 serial interrupts). When a direct or serial interrupt occurs and the sense bit is cleared (edge-sensitive), the interrupt-acknowledge cycle causes the corresponding bit in the IPR to be cleared. When the sense bit is set (level-activated), the corresponding IPR bit is not cleared until the source signal is negated.

Because an edge-sensitive interrupt is not cleared until it is acknowledged and the default polarity/sense bits for all interrupts are set to edge-sensitive at power-up, it is possible for the PIC unit to store detections of edges as pending interrupts. If software permanently sets the polarity/sense of an interrupt source to edge-sensitive and clears its mask bit, PIC can receive the vector for the interrupt source and not a spurious interrupt. To prevent having to

handle a false interrupt, see the programming note in Section 11.8, “Programming Guidelines.”

11.3.6.2 Interrupt Selector (IS)

The interrupt selector (IS) receives interrupt requests from the IPR. The output of the IS is the highest priority interrupt that was qualified. This output contains the priority of the selected interrupt and its source identification. The IS resolves an interrupt request in two clocks.

During an EOI cycle, the value in the in-service register (ISR) selects the bits that are cleared in the ISR. One cycle after an EOI cycle, the output of the IS contains the interrupt source identification and priority value to be cleared from the ISR. This interrupt source has the highest priority in the ISR.

11.3.6.3 Interrupt Request Register (IRR)

The IRR always passes the output of the IS except during interrupt acknowledge cycles. During interrupt acknowledge cycles, interrupts in the IS and IPR are not propagated to guarantee that the vector that is read from the interrupt acknowledge register is not changing with the arrival of a higher priority interrupt. The IRR also serves as a pipeline register for the two-clock propagation time through the IS.

11.3.6.4 In-Service Register (ISR)

The contents of the ISR are the priority and source values of the interrupts that are currently in service in the processor. The ISR receives an internal bit-set command during interrupt acknowledge cycles and an internal bit-clear command during EOI cycles.

11.4 PIC Pass-Through Mode

The PIC unit provides a mechanism to support alternate external interrupt controllers such as the PC-AT-compatible 8259 interrupt controller. After a hard reset, the PIC unit defaults to pass-through mode. In this mode, interrupts from external source IRQ0 are passed directly to the processor so that the interrupt signal from the external interrupt controller can be connected to IRQ0 to cause direct interrupts to the processor. Note that IRQ0/S_INT is an active-high signal, and that the PIC unit does not perform a vector fetch from an 8259 interrupt controller. The processor must perform a vector fetch.

When pass-through mode is enabled, none of the internally generated interrupts are forwarded to the processor. However, in pass-through mode, the PIC unit passes the raw interrupts from the MU (including watchpoint facility, DUART, and DMA unit) and I^2C to the $\overline{\text{L_INT}}$ output signal.

The pass-through mode is controlled by the GCR[M] bit (enabled when GCR[M] = 0). Note that when switching the PIC unit from pass-through to mixed mode (either direct or serial), the programming note in Section 11.8, “Programming Guidelines,” may apply.

11.5 PIC Direct Interrupt Mode

In direct interrupt mode, the IRQ[0:4] signals represent external interrupts that are controlled and prioritized by the five IRQ vector/priority registers (IVPR0–IVPR4) and the five IRQ destination registers (IDR0–IDR4). The external interrupts can be programmed for either level- or edge-sensitive activation and either polarity. The direct interrupt mode is selected when ICR[SIE] = 0. Note that ICR[SIE] has meaning only when GCR[M] = 1 (direct mode is a subset of mixed-mode operation).

11.6 PIC Serial Interrupt Interface

The serial interrupt mode is selected when ICR[SIE] = 1. Note that ICR[SIE] has meaning only when GCR[M] = 1 (serial interrupt mode is also a subset of mixed-mode operation). When the MPC8245 is in serial interrupt mode, 16 interrupt sources are supported through the following serial interrupt signals (that are multiplexed with the IRQ[0:4] input signals used in direct interrupt mode):

- Serial interrupt (S_INT) input signal
- Serial clock (S_CLK) output signal
- Serial reset (S_RST) output signal
- Serial frame ($\overline{\text{S_FRAME}}$) output signal

The 16 serial vector/priority registers (SVPR0–SVPR15) and the 16 serial destination registers (SIR0–SIR15) control and prioritize the 16 serial interrupts.

11.6.1 Sampling of Serial Interrupts

When the PIC unit is programmed for serial interrupts, 16 sources are sampled through the S_INT input signal. Each source (0–15) is allocated a one-cycle timeslot in a sequence of 16 cycles in which to request an interrupt. The serial interrupt interface is clocked by the PIC S_CLK output. This clock can be programmed to run at 1/2 to 1/14 of the MPC8245 SDRAM_CLK frequency by appropriately setting a 3-bit field in the serial interrupt configuration register. See Section 11.9.3, “PIC Interrupt Configuration Register (ICR).” If a frequency above 33 MHz is chosen, use extreme care to board noise problems. All references to the clock and cycles in this subsection refer to the S_CLK.

When PIC is switched to serial mode by setting ICR[SIE] = 1, a 16-cycle sequence begins 4 S_CLK cycles after PIC outputs a 2-cycle high pulse through the S_RST output signal. The 16-cycle sequence keeps repeating; after going from interrupt source cycle count of 0, 1, 2, 3, 4,... 15, the count immediately returns to 0, 1, 2, and so on, with no S_CLK delays

between cycle count 15 and the next cycle count 0. Each time the sequence count is pointing to interrupt source 0, the S_FRAME signal is active. S_FRAME is provided to guarantee synchronization between the MPC8245 PIC unit and the serial interrupt source device.

Note that interrupt source 0 is initially sampled at the fifth S_CLK rising edge after S_RST negates. Also, when S_RST is asserted, it is not asserted again until after an PIC reset, and the PIC unit is subsequently programmed to serial mode again.

11.6.2 Serial Interrupt Timing Protocol

Figure 11-3 shows the relative timing for the serial interrupt interface signals.

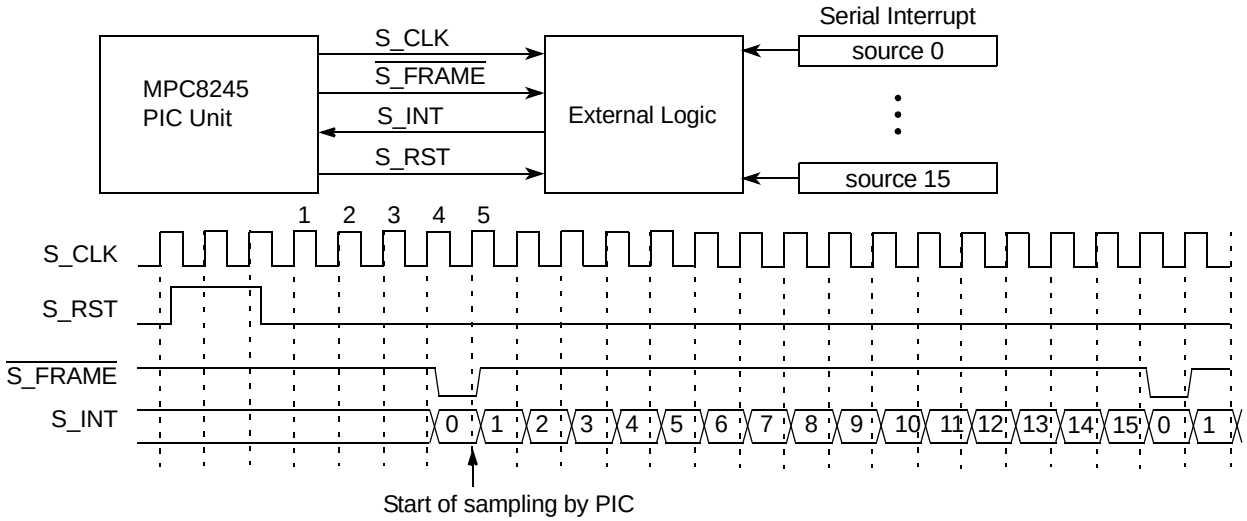


Figure 11-3. Serial Interrupt Interface Protocol

11.6.3 Edge/Level Sensitivity of Serial Interrupts

The interrupt detection is individually programmable for each source to be edge- or level-sensitive by writing the sense and polarity bits of the vector/priority register of the particular interrupt source. Refer to Section 11.3.6.1, “Interrupt Pending Register (IPR)—Nonprogrammable,” and the serial vector/priority register description in Section 11.9.8.1, “Direct and Serial Interrupt Vector/Priority Registers (IVPRs, SVPRs),” for more edge-/level-sensitivity information.

11.7 PIC Timers

The MPC8245 has appropriate clock prescalers and synchronizers to provide a time base for the four global timers (0–3) of the PIC unit. The global timers can be individually programmed to generate interrupts to the processor when they count down to zero and can be used for system timing or to generate regular periodic interrupts. Each timer has the following four registers for configuration and control:

- Global timer current count register (GTCCR)
- Global timer base count register (GTBCR)
- Global timer vector/priority register (GTVPR)
- Global timer destination register (GTDR)

The timers count at 1/8 the frequency of the SDRAM_CLK signals. The PIC unit has a timer frequency reporting register (TFRR) that can be written by software to store the value of the timer frequency (as described in Table 11-11). Although this frequency is affected by the setting of the PLL_CFG[0:4] signals at reset, the system software must know the SDRAM_CLK frequency to set this value accurately. (Simply reading an MPC8245 register cannot determine this frequency.) The value written to TFRR does not affect the frequency of the timers.

Timers 2 and 3 can be set up automatically to start periodic DMA operations for DMA channels 0 and 1, respectively, without using the processor interrupt mechanism. In this case, the timer interrupt should be masked (GTVPR[M] = 1), and GTBCR[CI] should be cleared to start the counting.

NOTE

To avoid an unpredictable operation, choose a rate for the timer so that the time between the interrupts is longer than the time that is required to complete the DMA chain.

To complete the initialization of the periodic DMA feature, the DMA channel must be configured for chaining mode and the DMR[PDE] for the appropriate channel must be set. See Section 8.3.2.2, “Periodic DMA Feature.”

The timer control register (TCR) provides users with the ability to create timers larger than the 31-bit global timers. Timer cascade bits allow the user to create up to two 63-bit timers, one 95-bit timer, or one 127-bit timer. A clock rollover provides a unit cascade mode. In this mode, timers can be treated as units of measurement. See Section 11.9.7.2, “Timer Control Register (TCR).”

11.8 Programming Guidelines

Accesses to the PIC unit include interrupt and timer initialization and reading the interrupt acknowledge register (IACK), which causes the PIC unit to return the vector associated with the interrupt to be serviced. External interrupt sources IRQ[0:4] can be programmed for either level- or edge-sensitive activation and either polarity. Similarly, all 16 serial interrupt sources can be programmed for either level- or edge-sensitive activation and for either polarity.

Most PIC control and status registers are readable and return the last value written. The exceptions to this rule are as follows:

- EOI register, which returns zeros on reads
- Activity bit (A) of the vector/priority registers, which returns the value according to the status of the current interrupt source
- IACK register, which returns the spurious vector or the vector of highest priority that is currently pending
- Reserved bits, which normally return 0

Do not assume that reserved fields always return 0. Reserved bits should always be written with the value they returned when read. Thus the registers with reserved fields should be programmed by reading the value, modifying the appropriate fields, and writing back the value.

Motorola recommends using the following guidelines when the PIC unit is programmed in mixed mode (GCR[M] = 1):

- If the processor's memory management unit (MMU) is enabled, all PIC registers must be located in a cache-inhibited and guarded area.
- The PIC portion of the embedded utilities memory block (EUMB) must be set up appropriately. (Registers within the EUMB are located from 0x8000_0000 to 0xFDFF_FFFF.)
- The PIC registers are described in this chapter in little-endian format. If the system is in big-endian mode, software must appropriately swap the bytes.

Furthermore, Motorola recommends the following initialization sequence:

1. Write the vector, priority, and polarity values in each interrupt's vector/priority register, leaving their M (mask) bit set. This step is required only if interrupts are used.
2. Set the processor current task priority register (PCTPR) value to zero.
3. Program the PIC to mixed mode by setting GCR[M] = 1.
4. If using direct mode, clear ICR[SIE]. Otherwise, to use serial mode, program the S_CLK ratio field in ICR[R] for the desired interrupt frequency and set ICR[SIE] = 1.
5. Clear the M bit in the vector/priority registers to be used.
6. Perform a software loop to clear all pending interrupts:
   — Load counter with FRR[NIRQ].
   — While counter > 0, perform IACK and EOIs to guarantee all the interrupt pending and in-service registers are cleared.
7. Set the PCTPR value to desired priority.

Depending on the interrupt system configuration, the PIC unit may generate false interrupts to clear out interrupts either latched during power-up or that resetting the PIC unit causes.

A spurious or real vector is returned for an interrupt acknowledge cycle. See the following sections for the cases that return a real interrupt vector for a false interrupt.

11.8.1 Edge-Sensitive False Interrupts

Because edge-sensitive interrupts are not cleared until acknowledged and the default polarity/sense bits for all interrupts are set to edge-sensitive, the PIC unit can store detections of edges at power-up as pending interrupts. If software permanently sets the polarity/sense of an interrupt source to edge-sensitive, it may receive the vector for the interrupt source rather than a spurious vector after software clears the mask bit. This event can occur once for any edge-sensitive interrupt source when its mask is first cleared and the PIC unit is in mixed mode.

To prevent complications from a false interrupt for this case, software can clear the PIC interrupt pending register of edges detected during power-up by first setting the polarity/sense bits of the interrupt source to level-sensitive as follows: high level, if the line is a positive-edge source; low level, if the line is a negative-edge source (and the mask bit should remain set). Software can then set the interrupt source's polarity/sense bits to the appropriate values.

11.8.2 Global Timer False Interrupts

A false interrupt is generated if the following sequence occurs:

1. Global timers are in use.
2. PIC unit is reset by setting GCR[R] while GTCCRx[T] is set.
3. The reset sequence completes.
4. The corresponding GTVPRx[M] bit is cleared.

By following the sequence recommended in steps 1–7 during the initialization of the PIC unit, this false interrupt can be handled without unexpected side effects. Unlike the above edge-sensitive case of false interrupts, no method can prevent having to handle this false interrupt.

11.9 Register Definitions

The following sections describe the registers of the PIC unit.

11.9.1 Feature Reporting Register (FRR)

The FRR provides information about the interrupt and processor configurations and contains controller version information. Note that this register is read-only. Figure 11-4 shows the bits in the FRR.

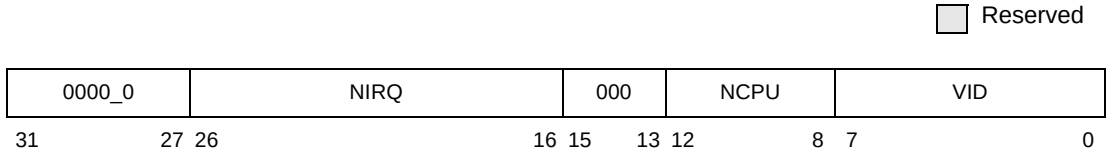


Figure 11-4. Feature Reporting Register (FRR)

Table 11-5 describes the bit settings for the FRR.

Table 11-5. FRR Field Descriptions—Offset 0x4_1000

Bits	Name	Reset Value	Description
31–27	—	All 0s	Reserved
26–16	NIRQ	0x019	Number of interrupts. This field contains the maximum number of interrupt sources supported. In the MPC8245, there are a maximum of 26 interrupts in use at one time: the 6 internal sources (I^2C, DMA (2), MU and DUART (2)), 4 timer sources, and 16 external sources. A zero in this field corresponds to one interrupt, and so on. Thus, the value of 0x019 corresponds to 24 interrupts.
15–13	—	All 0s	Reserved
12–8	NCPU	0x00	Number of CPUs. This field contains the number of the highest CPU supported. Because one CPU is supported by the MPC8245 PIC unit, the value is zero corresponding to CPU 0.
7–0	VID	0x02	Version ID for this interrupt controller. This value reports the level of OpenPIC specification supported by this implementation. VID =2, representing version level 1.2 of OpenPIC, for the initial release of the MPC8245.

11.9.2 Global Configuration Register (GCR)

The GCR provides programming control for resetting the PIC unit and setting the external interrupts mode. Note that this register is read/write. Figure 11-5 shows the bits in the GCR.

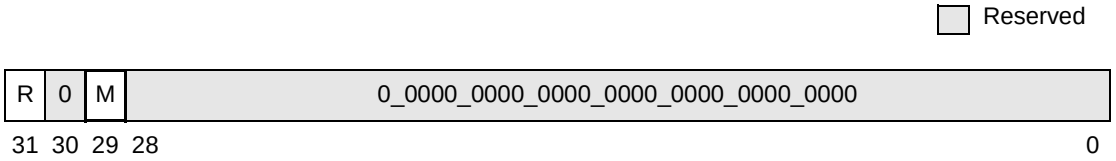


Figure 11-5. Global Configuration Register (GCR)

Table 11-6 describes the bit settings for the GCR.

Table 11-6. GCR Field Descriptions—Offset 0x4_1020

Bits	Name	Reset Value	Description
31	R	0	Reset PIC unit. Writing a one to this bit resets the PIC controller logic. This bit is cleared automatically when this reset sequence is complete. Setting this bit causes the following: • All pending and in-service interrupts are cleared • All interrupt mask bits are set • All timer base count values are reset to zero and count inhibited • The processor current task priority is reset to 0xF thus disabling interrupt delivery to the processor • Spurious vector resets to 0xFF • PIC defaults to pass-through mode • The serial clock ratio resets to 0x4 All other registers remain at their pre-reset programmed values.
30	—	0	Reserved
29	M	0	Mode 0 Pass-through mode. PIC is disabled and interrupts detected on IRQ0 (active-high) are passed directly to the processor core. 1 Mixed-mode. When this bit is set, ICR[SIE] determines whether the PIC unit is operating in direct or serial interrupts mode.
28–0	—	All 0s	Reserved

11.9.3 PIC Interrupt Configuration Register (ICR)

The ICR provides programming control for the serial interrupt mode and serial clock frequency. Note that this register is read/write. Figure 11-6 shows the bits in the ICR.

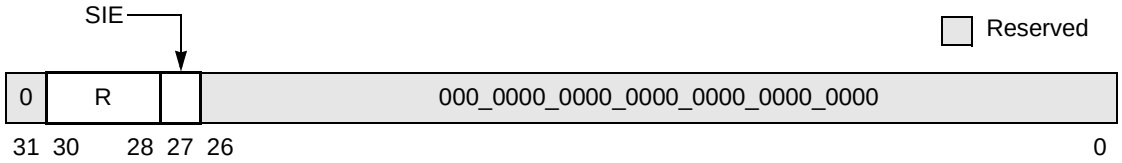


Figure 11-6. PIC Interrupt Configuration Register (ICR)

Table 11-7 describes the bit settings for the ICR.

Table 11-7. ICR Field Descriptions—Offset 0x4_1030

Bits	Name	Reset Value	Description
31	—	0	Reserved
30–28	R	0x4	Clock ratio. The S_CLK signal is driven by PIC at a frequency of the SDRAM_CLK frequency divided by twice the value of this 3-bit field. The reset value of this field is 0x4. At this value, the S_CLK signal operates at 1/8 the frequency of the SDRAM_CLK signal. The allowable range of values for this field is between 1 and 7, resulting in a clock division ratio between 2 and 14, respectively. Note that an illegal value could result in spurious vectors returned when in either direct or serial mode.

Table 11-7. ICR Field Descriptions—Offset 0x4_1030 (continued)

Bits	Name	Reset Value	Description
27	SIE	0	Serial interrupt enable. This bit selects whether the MPC8245 IRQ signals are configured for direct interrupts or serial interrupts. The GCR[M] must be set (mixed-mode) in order for this bit value to have meaning. 0 Direct interrupts mode 1 Serial interrupts mode
26–0	—	All 0s	Reserved

11.9.4 PIC Vendor Identification Register (EVI)

The EVI has specific read-only information about the vendor and the device revision. Figure 11-7 shows the bits in the EVI.

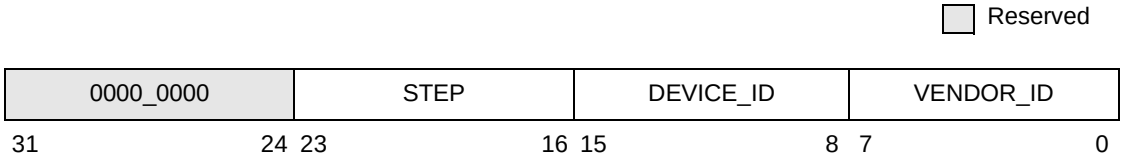


Figure 11-7. PIC Vendor Identification Register (EVI)

Table 11-8 describes the bit settings for the EVI.

Table 11-8. EVI Register Field Descriptions—Offset 0x4_1080

Bits	Name	Reset Value	Description
31–24	—	All 0s	Reserved
23–16	STEP	0x01	Stepping. This indicates the stepping (silicon revision) for this device.
15–8	DEVICE_ID	All 0s	Device identification
7–0	VENDOR_ID	All 0s	Vendor identification. Because this value is zero, the MPC8245 is considered to be a generic PIC-compliant device.

11.9.5 Processor Initialization Register (PI)

The PI provides a mechanism for the software, through the PIC unit, to cause a soft reset of the processor by asserting the *sreset* signal. Note that this register is read/write. Figure 11-8 shows the bits in the PI.

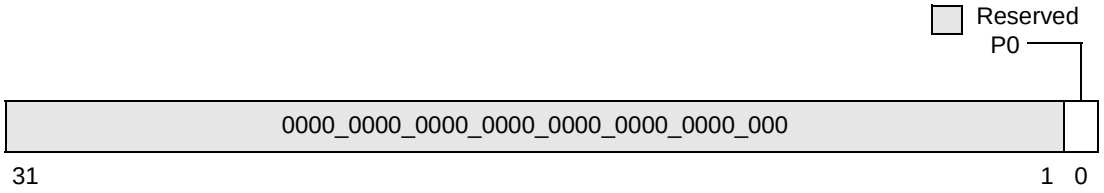


Figure 11-8. Processor Initialization Register (PI)

Table 11-9 describes the bit settings for the PI.

Table 11-9. PI Register Field Descriptions—Offset 0x4_1090

Bits	Name	Reset Value	Description
31–1	—	All 0s	Reserved
0	P0	0	Processor 0 soft reset 0 Default value 1 Setting this bit causes the PIC unit to assert the internal *sreset* signal to the processor core, causing a soft reset exception. The *sreset* signal is edge-sensitive to the processor, but it is held high until a zero is written to P0. Thus, it should be cleared by software as soon as possible in the soft reset exception handler.

11.9.6 Spurious Vector Register (SVR)

The SVR contains the 8-bit vector returned to the processor during an interrupt acknowledge cycle for the cases described in Section 11.3.5, “Spurious Vector Generation.” Note that this register is read/write. Figure 11-9 shows the bits in the SVR.

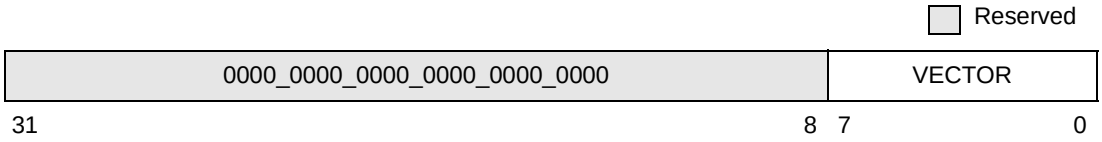


Figure 11-9. Spurious Vector Register (SVR)

Table 11-10 describes the bit settings for the SVR.

Table 11-10. SVR Field Descriptions—Offset 0x4_10E0

Bits	Name	Reset Value	Description
31–8	—	All 0s	Reserved
7–0	VECTOR	0xFF	Spurious interrupt vector. The vector value in this field is returned when the interrupt acknowledge register (IACK) is read during a spurious vector fetch.

11.9.7 Global Timer Registers

This section describes the global timer registers. Note that each of the four timers (timer 0–timer 3) has four individual configuration registers (GTCCR*n*, GTBCR*n*, GTVPR*n*, GTDR*n*), but they are shown only once in this section.

11.9.7.1 Timer Frequency Reporting Register (TFRR)

Software writes the TFRR to report the clocking frequency of the PIC timers. Note that although this register is read/write, the PIC unit ignores the value in this register. Figure 11-10 shows the bits in the TFRR.

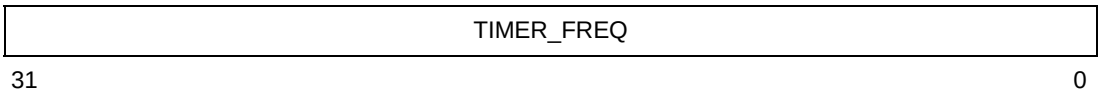


Figure 11-10. Timer Frequency Reporting Register (TFRR)

Table 11-11 describes the bit settings for the TFRR.

Table 11-11. TFRR Field Descriptions—Offset 0x4_10F0

Bits	Name	Reset Value	Description
31–0	TIMER_FREQ	All 0s	Timer frequency. This register is used to report the frequency of the clock source for the global timers (in ticks/second (Hz)), which is always the SDRAM_CLK signal. The timers operate at 1/8 the speed of the SDRAM_CLK signal. The register is set only by software. The value in this register does not affect the speed of the timers. The timers' speeds are determined by the PLL_CFG[0–4] signals and the frequency of the PCI_SYNC_IN signal. The value may be written by the system initialization code after the SDRAM_CLK frequency has been determined by the firmware. The firmware can use information stored in the HID1 register and information about the actual processor frequency to determine the SDRAM_CLK frequency. However, in some cases, more system frequency information may be required.

11.9.7.2 Timer Control Register (TCR)

The TCR provides users with the ability to create timers larger than the default 31-bit global timers. Timer cascade bits allow the user to create up to two 63-bit timers, one 95-bit timer, or one 127-bit timer. Figure 11-11 shows the bits in the TCR.

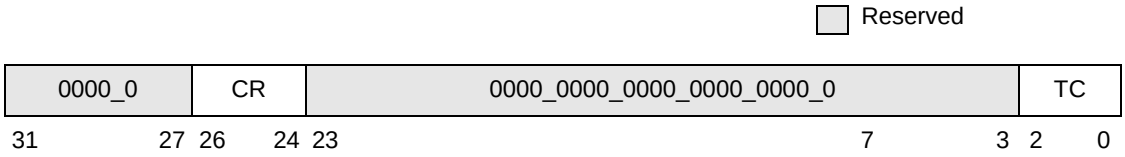


Figure 11-11. Timer Control Register

Table 11-12 describes the bit settings for the TCR.

Table 11-12. TCR Field Descriptions—Offset 0x4_10F4

Bits	Name	Reset Value	Description
31-27	—	All 0s	Reserved
26-24	CR	All 0s	Clock rollover 0 Default value. When the timer reaches zero, it is reloaded with the value in the base count register. If the value in the most significant timer is non-zero, timer rolls over from 0 to the value in the base count register (unit cascade mode). 1 Timer rolls over from 0 to 0xFFFF if the value in the most significant timer with which it is cascaded is non-zero (normal cascade mode). In unit cascade mode, timers can be treated as units of measurement. For example, timers 0, 1, and 2 can be tied together. If the memory interface is operating at 100 MHz and timer 0 is set to 0x5F5E100 ticks/sec, timer 1 to 60 sec/min, and timer 2 to 60 min/hour, an interrupt is generated every hour: (0x5F5E100 ticks/sec) * (60 sec/min) * (60 min/hr). In either case (normal or unit cascade mode), the base count register is reloaded for each timer when all the timers that are tied together in cascade mode hit the value of zero. bit 24—Timer 0 rollover. bit 25—Timer 1 rollover. bit 26—Timer 2 rollover. Note that global timer 3 always reloads the base count register after it hits zero.
23-3	—	All 0s	Reserved.
2-0	TC	All 0s	Timer cascade. Combines a particular global timer with another. bit 0—When set, combines global timer 0 with global timer 1 (global timer 1 contains the most significant bytes among the two timers; timer 0 has 32 bits of data, timer 1 has 31 bits plus a count inhibit bit). bit 1—When set, combines global timer 1 with global timer 2 (global timer 2 contains the most significant bytes among the two timers). bit 2—When set, combines global timer 2 with global timer 3 (global timer 3 contains the most significant bytes among the two timers). One or more of the TC bits can be set. An example of a 95-bit timer would be to set TC bit 1 and 2, which would result in timer 1, 2, and 3 being combined as one entity. Timer 3 would contain the most significant bytes of the three; timer 1 and 2 have 32 bits of data each; timer 3 has 31 bits plus a count inhibit bit. At the same time, global timer 0 would default to a separate 31-bit timer with a count inhibit bit.

11.9.7.3 Global Timer Current Count Registers (GTCCRn)

The GTCRRs contain the current count for each of the four PIC timers. Note that these registers are read-only. The address offsets from EUMBBAR for the GTCCRs are described in Table 11-13.

Table 11-13. EUMBBAR Offsets for GTCCRs

GTCCR	Offset
GTCCR0	0x4 _1100
GTCCR1	0x4_1140
GTCCR2	0x4_1180
GTCCR3	0x4_11C0

Figure 11-12 shows the bits of the GTCCRs.

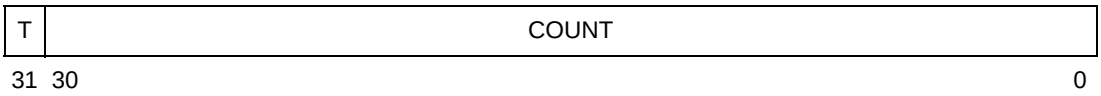


Figure 11-12. Global Timer Current Count Register (GTCCR)

Table 11-14 describes the bit settings for the GTCCRs.

Table 11-14. GTCCR Field Descriptions

Bits	Name	Reset Value	Description
31	T	0	Toggle. This bit toggles whenever the current count decrements to zero.
30–0	COUNT	All 0s	Current timer count. This 31-bit field is decremented while the GTBCR[CI] bit is zero. When the timer counts down to zero, this field is reloaded from the base count register, the toggle bit is inverted, and an interrupt is generated (provided it is not masked).

11.9.7.4 Global Timer Base Count Registers (GTBCRn)

The GTBCRs contain the base count for each of the four PIC timers. This value is reloaded into the GTCCRs when they count down to zero. Note that these registers are read/write. The address offsets from EUMBBAR for the GTBCRs are described in Table 11-15.

Table 11-15. EUMBBAR Offsets for GTBCRs

GTBCR	Offset
GTBCR0	0x4_1110
GTBCR1	0x4_1150
GTBCR2	0x4_1190
GTBCR3	0x4_11D0

Figure 11-13 shows the bits of the GTBCRs.

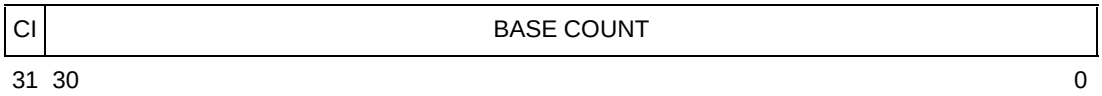


Figure 11-13. Global Timer Base Count Register (GTBCR)

Table 11-16 describes the bit settings for the GTBCRs.

Table 11-16. GTBCR Field Descriptions

Bits	Name	Reset Value	Description
31	CI	1	Count inhibit 0 Enables counting for this timer 1 Inhibits counting for this timer
30–0	BASE_COUNT	All 0s	Base count. This 31-bit field contains the base count used for this timer. When a value is written into this register and the CI bit transitions from a 1 to a 0, the base count value is copied into the corresponding current count register and the toggle bit is cleared.

11.9.7.5 Global Timer Vector/Priority Registers (GTVPRs)

The GTVPRs contain the interrupt vector and the interrupt priority for each of the four timers. In addition, they contain the mask and activity bits for each of the four timers. Note that these registers are read/write. The address offsets from EUMBBAR for the GTVPRs are described in Table 11-17.

Table 11-17. EUMBBAR Offsets for GTVPRs

GTVPR	Offset
GTVPR0	0x4_1120
GTVPR1	0x4_1160
GTVPR2	0x4_11A0
GTVPR3	0x4_11E0

Figure 11-14 shows the bits of the GTVPRs.

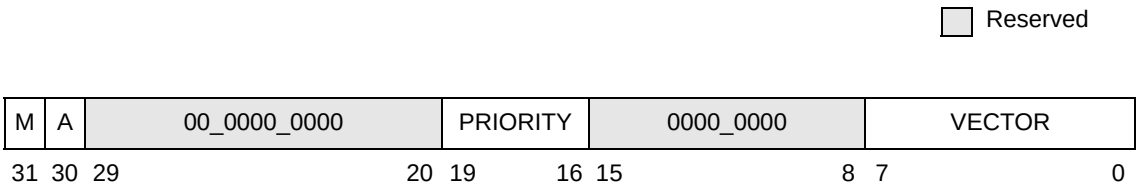


Figure 11-14. Global Timer Vector/Priority Registers (GTVPR)

Table 11-18 describes the bit settings for the GTVPRs.

Table 11-18. GTVPRs Field Descriptions

Bits	Name	Reset Value	Description
31	M	1	Mask. Mask interrupts from this timer 0 If the mask bit is cleared while the corresponding IPR bit is set, $\overline{int}$ is asserted to the processor. 1 Further interrupts from this timer are disabled
30	A	0	Activity. Indicates that an interrupt has been requested or that it is in service. Note that this bit is read-only. 0 No current interrupt activity associated with this timer 1 The interrupt bit for this timer is set in the IPR or ISR The VECTOR and PRIORITY values should not be changed while the A bit is set.
29–20	—	All 0s	Reserved
19–16	PRIORITY	0x0	Priority. This field contains the 4-bit interrupt priority. The lowest priority is 0 and the highest is 15. A priority level of 0 disables interrupts from this timer.
15–8	—	0x00	Reserved
7–0	VECTOR	0x00	Vector. The vector value in this field is returned when the interrupt acknowledge register (IACK) is read and the interrupt associated with this vector has been requested.

11.9.7.6 Global Timer Destination Registers (GTDRs)

Each GTDR indicates the destination for the timer's interrupt. Because the MPC8245 PIC unit supports a single processor, the destination is always P0. Note that this register is read-only. Table 11-19 shows the address offsets from EUMBBAR for the GTDRs.

Table 11-19. EUMBBAR Offsets for GTDRs

GTDR	Offset
GTDR0	0x4_1130
GTDR1	0x4_1170
GTDR2	0x4_11B0
GTDR3	0x4_11F0

Figure 11-15 shows the bits of the GTDRs.

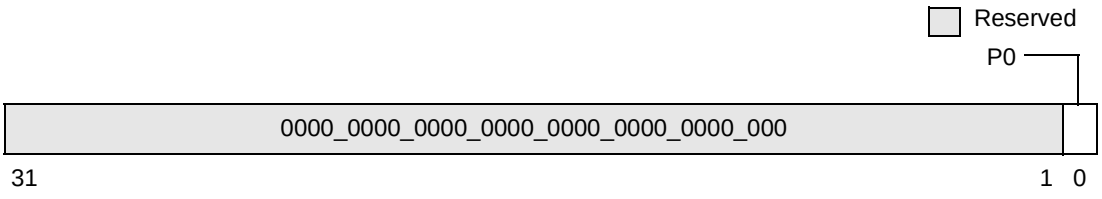


Figure 11-15. Global Timer Destination Register (GTDR)

Table 11-20 describes the bit settings for the GTDRs.

Table 11-20. GTDRs Field Descriptions

Bits	Name	Reset Value	Description
31–1	–	All 0s	Reserved
0	P0	1	Processor 0. Timer interrupt is always directed to the processor core.

11.9.8 External (Direct and Serial) and Internal Interrupt Registers

This section describes the vector/priority and destination registers for the external (direct and serial), and internal (I^2C, DMA, and MU) interrupt sources.

11.9.8.1 Direct and Serial Interrupt Vector/Priority Registers (IVPRs, SVPRs)

The format for the IRQ0–4 (direct) vector/priority registers (IVPRs) is identical to that of the vector/priority registers for the 16 serial interrupts (SVPRs). Note that these registers are read/write. Table 11-21 shows the address offsets from EUMBBAR for the IVPRs and SVPRs.

Table 11-21. EUMBBAR Offsets for IVPRs and SVPRs

IVPR	Offset	SVPR	Offset	SVPR	Offset
IVPR0	0x5_0200	SVPR0	0x5_0200	SVPR8	0x5_0300
IVPR1	0x5_0220	SVPR1	0x5_0220	SVPR9	0x5_0320
IVPR2	0x5_0240	SVPR2	0x5_0240	SVPR10	0x5_0340
IVPR3	0x5_0260	SVPR3	0x5_0260	SVPR11	0x5_0360
IVPR4	0x5_0280	SVPR4	0x5_0280	SVPR12	0x5_0380
		SVPR5	0x5_02A0	SVPR13	0x5_03A0
		SVPR6	0x5_02C0	SVPR14	0x5_03C0
		SVPR7	0x5_02E0	SVPR15	0x5_03E0

Figure 11-16 shows the bits of the IVPRs and SVPRs.

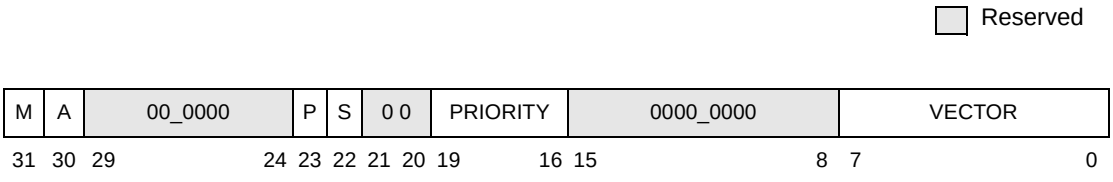


Figure 11-16. Direct and Serial Interrupt Vector/Priority Registers (IVPRs and SVPRs)

Table 11-22 shows the bit settings for the IVPRs and SVPRs.

Table 11-22. IVPR and SVPR Field Descriptions

Bits	Name	Reset Value	Description
31	M	1	Mask. Masks interrupts from this source. 0 If the mask bit is cleared while the corresponding IPR bit is set, $\overline{int}$ is asserted to the processor. 1 Further interrupts from this source are disabled
30	A	0	Activity. Indicates that an interrupt has been requested or that it is in-service. Note that this bit is read-only. 0 No current interrupt activity associated with this source 1 The interrupt bit for this source in the IPR or ISR is set The VECTOR, PRIORITY, P (polarity), or S (sense) values should not be changed while the A bit is set, except to clear an old interrupt.
29–24	—	All 0s	Reserved
23	P	0	Polarity. This bit sets the polarity for the external interrupt. 0 Polarity is active-low or negative-edge triggered 1 Polarity is active-high or positive-edge triggered
22	S	0	Sense. This bit sets the sense for external interrupts. 0 The external interrupt is edge-sensitive. 1 The external interrupt is level-sensitive.
21–20	—	All 0s	Reserved
19–16	PRIORITY	0x0	Priority. This field contains the 4-bit interrupt priority. The lowest priority is 0 and the highest is 15. A priority level of 0 disables interrupts from this source.
15–8	—	0x00	Reserved
7–0	VECTOR	0x00	Vector. The vector value in this field is returned when the interrupt acknowledge register (IACK) is read and the interrupt associated with this vector has been requested.

11.9.8.2 Direct and Serial Interrupt Destination Registers (IDRs and SIRs)

The IDRs and SIRs indicate the destination for each external interrupt source. Because the MPC8245 is a single-processor device, the destination is always P0. Note that these registers are read-only. Table 11-23 shows the address offsets from EUMBBAR for the IDRs and SIRs.

Table 11-23. EUMBBAR Offsets for IDRs and SIRs

IDR	Offset	SIR	Offset	SIR	Offset
IDR0	0x5_0210	SIR0	0x5_0210	SIR8	0x5_0310
IDR1	0x5_0230	SIR1	0x5_0230	SIR9	0x5_0330
IDR2	0x5_0250	SIR2	0x5_0250	SIR10	0x5_0350
IDR3	0x5_0270	SIR3	0x5_0270	SIR11	0x5_0370

Table 11-23. EUMBBAR Offsets for IDRs and SIRs (continued)

IDR	Offset	SIR	Offset	SIR	Offset
IDR4	0x5_0290	SIR4	0x5_0290	SIR12	0x5_0390
		SIR5	0x5_02B0	SIR13	0x5_03B0
		SIR6	0x5_02D0	SIR14	0x5_03D0
		SIR7	0x5_02F0	SIR15	0x5_03F0

Figure 11-17 shows the bits of the IDRs and SIRs.

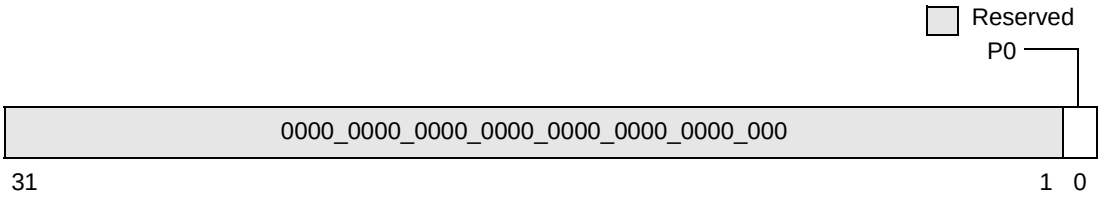


Figure 11-17. Direct and Serial Destination Registers (IDR and SIR)

Table 11-24 shows the bit settings for the IDRs and SIRs.

Table 11-24. IDRs and SIRs Field Descriptions

Bits	Name	Reset Value	Description
31–1	—	All 0s	Reserved
0	P0	1	Processor 0. Direct and serial interrupts always directed to the processor.

11.9.8.3 Internal (I^2C, DMA, MU, DUART) Interrupt Vector/Priority Registers (IIVPRs)

The IIVPRs (see Table 11-25) have the same format and field descriptions as the GTVPRs, except that they apply to the internal MPC8245 interrupt sources—the I^2C unit, DMA unit (2 channels), MU, and DUART. See Section 11.9.7.5, “Global Timer Vector/Priority Registers (GTVPRs),” for a complete description of the GTVPRs.

Table 11-25. EUMBBAR Offsets for IIVPRs

IIVPR	Offset
IIVPR0	0x5_1020
IIVPR1	0x5_1040
IIVPR2	0x5_1050
IIVPR3	0x5_10C0
IIVPR4	0x5_1120
IIVPR5	0x5_1140

11.9.8.4 Internal (I^2C, DMA, MU, or DUART) Interrupt Destination Registers (IIDRs)

The IIDRs (see Table 11-26) have the same format and field descriptions as the IDRs (and SIRs), except that they apply to the internal MPC8245 interrupt sources—the I^2C unit, DMA unit (2 channels), DUART, and MU. See Section 11.9.8.2, "Direct and Serial Interrupt Destination Registers (IDRs and SIRs)," for a complete description of the IDRs.

Table 11-26. EUMBBAR Offsets for IIDRs

IIDR	Offset
IIDR0	0x5_1030
IIDR1	0x5_1060
IIDR2	0x5_1070
IIDR3	0x5_10D0
IIDR4	0x5_1130
IIDR5	0x5_1150

11.9.9 Processor-Related Registers

This section describes the processor-related PIC registers.

11.9.9.1 Processor Current Task Priority Register (PCTPR)

Software should write the priority of the current processor task in the PCTPR. The PIC unit uses this value to compare with the priority of incoming interrupts. The $\overline{int}$ signal is asserted to the processor core if the incoming interrupt is not masked, has a greater priority than that assigned in the PCTPR and ISR, and is greater than the priority of the other incoming interrupts. Priority levels from 0 (lowest) to 15 (highest) are supported. Setting the task priority to 15 masks all interrupts to the processor. The PCTPR is initialized to 0x0000_000F when the MPC8245 is reset, or when the P0 bit of the processor initialization register is set to one. Note that this register is read/write. Figure 11-18 shows the bits of the PCTPR.

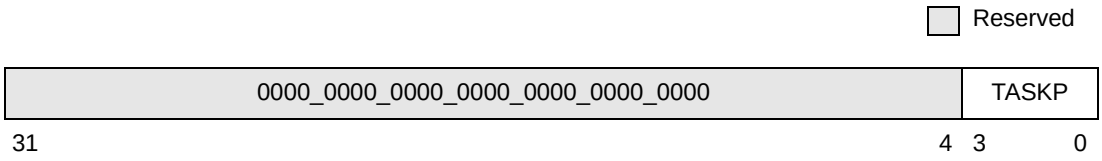


Figure 11-18. Processor Current Task Priority Register (PCTPR)

Table 11-27 shows the bit settings for the PCTPR.

Table 11-27. PCTPR Field Descriptions—Offset 0x6_0080

Bits	Name	Reset Value	Description
31–4	—	All 0s	Reserved
3–0	TASKP	0xF	Task priority. This field is set 0 to 15, where 15 corresponds to the highest priority for processor tasks. When PCTPR[TASKP] = 0xF, no interrupts will be signaled to the processor.

11.9.9.2 Processor Interrupt Acknowledge Register (IACK)

The interrupt acknowledge mechanism on the MPC8245 consists of a read from the memory-mapped interrupt acknowledge register (IACK) in the PIC unit. Reading the IACK returns the interrupt vector corresponding to the highest priority pending interrupt. Reading IACK also has the following side effects:

- Associated bit in the IPR is cleared (if it is configured as edge-sensitive).
- ISR is updated.
- Internal $\overline{int}$ signal is negated.

Reading IACK when no interrupt is pending returns the spurious vector value. Note that this register is read-only.

Figure 11-19 shows the bits of the IACK.

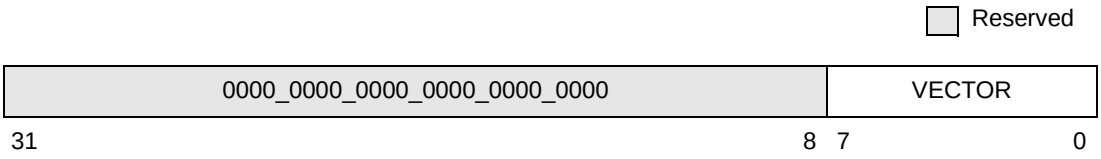


Figure 11-19. Processor Interrupt Acknowledge Register (IACK)

Table 11-28 shows the bit settings of the IACK.

Table 11-28. IACK Field Descriptions—Offset 0x6_00A0

Bits	Name	Reset Value	Description
31–8	—	All 0s	Reserved
7–0	VECTOR	0x0	Interrupt vector. When this register is read, this field returns the vector of the highest pending interrupt in the PIC unit.

11.9.10 Processor End-of-Interrupt Register (EOI)

A write to the EOI signals the end of processing for the highest priority interrupt that is currently in service by the processor. The write to EOI updates the ISR by retiring the

highest priority interrupt. Data values written to this register are ignored, and zero is assumed. Reading this register returns zeros (this register is considered write-only). Figure 11-20 shows the bits of the EOI.

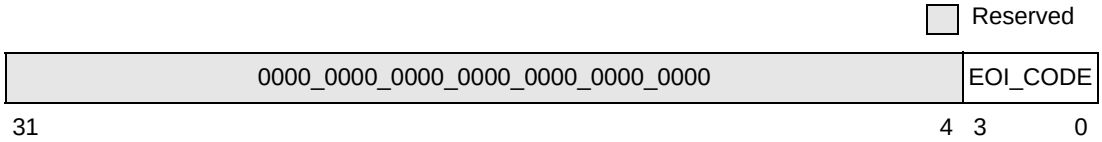


Figure 11-20. Processor End of Interrupt Register (EOI)

Table 11-29 shows the bit settings for the EOI.

Table 11-29. EOI Field Descriptions—Offset 0x6_00B0

Bits	Name	Reset Value	Description
31–4	—	—	Reserved.
3–0	EOI_CODE	—	The EOI codes, other than 0, are undefined.

Chapter 12
DUART Unit

This chapter describes the two (dual) universal asynchronous receiver/transmitters (UARTs) of the MPC8245—their operation, the DUART initialization sequence, and programming details for the DUART registers and features.

12.1 DUART Overview

The MPC8245's DUART controls the processor core interface to the serial devices attached to the UART signals. Each UART is capable of converting the parallel data from the processor core into a single serial bit stream for outbound transmission. On inbound transmission, the UART converts the serial bit stream into the bytes for those that the processor core handles.

12.1.1 DUART Unit Features

The MPC8245 has two independent UARTs that are equipped with a 16-byte FIFO (first in, first out) buffer. Thus, the processor core needs to respond to the incoming data every 16 bytes instead of processing every character as they are received. Some of the features of the MPC8245 DUART unit include the following:

- Full-duplex operation
- Program model compatible with the original 16450 UART and the PC16550D (an improved version of the 16450 that can be put into an alternate mode such as FIFO mode)
- 16450 register reset values
- FIFO mode for both transmitter and receiver for 16-byte FIFOs
- Serial data encapsulation and decapsulation with standard asynchronous communication bits (START, STOP, and parity)
- Maskable transmit, receive, line status, and MODEM status interrupts
- Software-programmable baud generators that divide SDRAM_CLK*n* by 1 to (2^{16} - 1) and generate a 16x clock
- Clear to send ($\overline{\text{CTS}}$) and ready to send ($\overline{\text{RTS}}$) MODEM control functions

- Software-selectable serial-interface data format (data length, parity, 1/1.5/2 STOP bit, baud rate)
- Line and MODEM status registers
- Line-break detection and generation
- Internal diagnostic support, local loopback, and break functions
- Prioritized interrupt reporting
- Four-signal DUART mode
- Overrun, parity, and framing error detection
- Programmable registers accessed from the PCI bus or the processor core
- Programmable interrupt direction to the processor core, through the PIC unit, or to the PCI bus

12.1.2 DUART Block Diagram

The MPC8245's two UART units act independently and are clocked by SDRAM_CLK*n*. The DUART unit interfaces directly to the peripheral logic bus and is also accessible from the PCI bus. Because the external DUART unit interface is point-to-point, only two UART devices can be connected to the interface at one time.

As shown in Figure 12-1, the UART1 consists of the following major functional blocks:

- Receive and transmit buffers
- $\overline{\text{CTS}}$ and $\overline{\text{RTS}}$ input and output ports for data flow control
- Sixteen-bit counter for baud rate generation
- Internal channel control logic
- Interrupt control logic

The following block diagram shows the UART unit and the relationship between peripheral logic bus, external signals, and the UART unit:

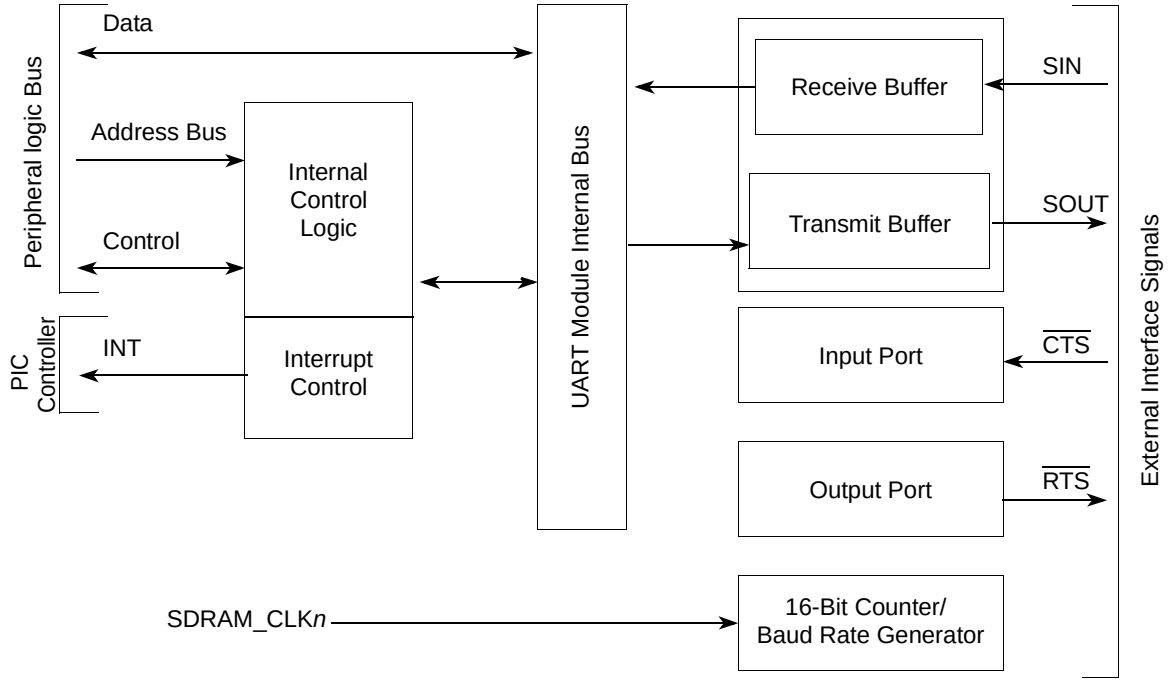


Figure 12-1. UART Block Diagram

12.1.3 DUART Signal Description

Table 12-1 describes the external DUART signals.

Table 12-1. DUART Signal Descriptions

Signal Name	Pins	I/O	Reset Value	State Meaning
SIN1	1	I	1	Serial in data. Data received on UART1 receiver serial data input signal, with the least significant bit received first.
SOUT1	1	O	1	Serial out data. UART1 transmitter serial data output signal is held high ('mark' condition) when the transmitter is disabled, idle, or operating in the local loop back mode. Data is shifted out on this signal, with the least significant bit transmitted first.

Table 12-1. DUART Signal Descriptions (continued)

Signal Name	Pins	I/O	Reset Value	State Meaning
$\overline{\text{CTS1}}$/SIN2	1	I	1	Four-signal UART mode—Clear to send. This active-low UART1 input is connected to the $\overline{\text{RTS}}$ output of the external UART device on the bus. The input can generate an interrupt on change-of-state of the pin. Four-signal DUART mode—Serial in data. Data received on UART2 receiver serial data input signal, with the least significant bit received first
$\overline{\text{RTS1}}$/SOUT2	1	O	1	Four-signal UART mode—Ready to send. An active-low UART1 output signal that can be programmed to be negated or asserted. When connected to the clear to send ($\overline{\text{CTS}}$) input of an external device, this signal can be used as a 'ready to send/receive data' indication to control data flow Four-signal DUART mode—Serial out data. UART2 transmitter serial data output signal is held high ('mark' condition) when the transmitter is disabled, idle, or operating in the local loop back mode. Data is shifted out on this signal, with the least significant bit transmitted first.

12.1.4 DUART Signal Mode Selection

The DUART unit operates in mainly two modes—four-signal UART and four-signal DUART mode. The SOUT2/$\overline{\text{RTS1}}$ and SIN2/$\overline{\text{CTS1}}$ signals are multiplexed. The DCR[SDM] bit that is described in Table 12-20 determines the functionality of the signals and mode setting.

In four-signal UART mode, only UART1 is available and the following signals are used: SOUT1, $\overline{\text{CTS1}}$, SIN1, $\overline{\text{RTS1}}$. In the 4-signal DUART mode, SIN1, SOUT1, SIN2, and SOUT2 are used such that SIN2 and $\overline{\text{CTS1}}$ share the same signal, and SOUT2 and $\overline{\text{RTS1}}$ share the same signal. In this case, the $\overline{\text{CTS}}$ and $\overline{\text{RTS}}$ functions are disabled.

Figure 12-2 shows how the DUART unit can be used in either the four-signal UART mode or the four-signal DUART mode.

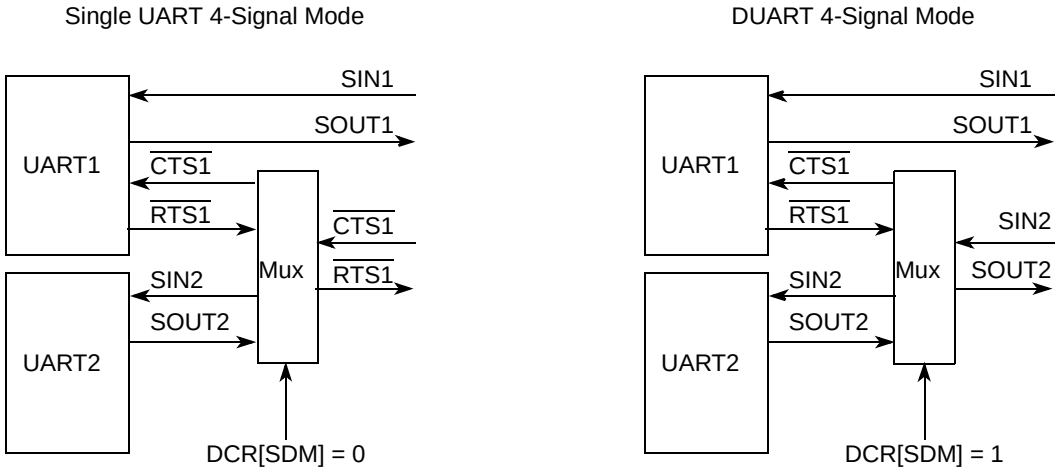


Figure 12-2. Single UART/DUART Mode Signal Multiplexing

12.1.5 DUART Register Summary

The two complete sets of DUART registers on the MPC8245 are for UART1 and UART2. The DUART registers of the MPC8245 comprise part of the MPC8245 embedded utilities and are memory-mapped. The PCSRBAR for accesses from PCI memory space and the EUMBBAR for accesses from local memory determine base addresses for the DUART registers. See Section 3.4, “Embedded Utilities Memory Block (EUMB),” for more information.

The two UARTs on the MPC8245 are identical, except that the registers for UART1 are located at offsets 0x500(PCI) and 0x0_4500(local), and the registers for UART2 are located at offsets 0x600(PCI) and 0x0_4600(local). Throughout this chapter, the registers are described by a singular acronym (for example, DCR stands for the DUART configuration register for either UART1 or UART2). The 14 registers in each UART interface are used for configuration, control, and status. Each register is 8-bits wide. The divisor latch access bit, ULCR[DLAB], accesses the divisor latch least- and most-significant bit registers and alternate function register. See Table 12-12 for more information on ULCR[DLAB].

Table 12-2 summarizes the DUART registers on the MPC8245

Table 12-2. DUART Register Summary

PCI Memory Offset	Local Memory Offset	Divisor Latch Access Bit ULCR[DLAB]	Register Name	Register Description
0x500	0x0_4500	0	UART1 receiver buffer register (URBR)	Contains the data received from the external device on the UART bus. This register is read only. See Section 12.4.1, “Receiver Buffer Register (URBR).”
0x500	0x0_4500	0	UART1 transmitter holding register (UTHR)	A write to this register causes the UART device to transfer 5 to 8 data bits on the UART bus in the format set up in the ULCR. This register is write only. See Section 12.4.3, “Transmitter Holding Register (UTHR).”
0x500	0x0_4500	1	UART1 divisor least significant byte register (UDLB)	Combines with the UDMB to create the divisor of the DUART clock. See Section 12.4.2, “Divisor Most and Least Significant Byte Registers (UDMB and UDLB).”
0x501	0x0_4501	0	UART1 interrupt enable register (UIER)	Allows the ability to mask specific UART interrupts to the processor core or the PCI bus. See Section 12.4.4, “Interrupt Enable Register (UIER).”
0x501	0x0_4501	1	UART1 divisor most significant byte register (UDMB)	Combines with the UDLB to create the divisor of the DUART clock. See Section 12.4.2, “Divisor Most and Least Significant Byte Registers (UDMB and UDLB).”
0x502	0x0_4502	0	UART1 interrupt ID register (UIIR)	Indicates when and what type of interrupt is pending. This register is read only. See Section 12.4.5, “Interrupt ID Register (UIIR).”

Table 12-2. DUART Register Summary (continued)

PCI Memory Offset	Local Memory Offset	Divisor Latch Access Bit ULCR[DLAB]	Register Name	Register Description
0x502	0x0_4502	0	UART1 FIFO control register (UFCR)	Enables and clears the receiver and transmitter FIFOs, sets a receiver FIFO trigger level, and selects type of DMA signalling. This register is write only. See Section 12.4.6, “FIFO Control Register (UFCR).”
0x502	0x0_4502	1	UART1 alternate function register (UAFR)	Enables software to write concurrently to both UART1 and UART2 registers with the same write operation. The UAFR also provides a means for the MPC8245's performance monitor to track the baud clock. See Section 12.4.12, “Alternate Function Register (UAFR).”
0x503	0x0_4503	x	UART1 line control register (ULCR)	Specifies the data format for the UART bus and sets the divisor latch access bit (DLAB). See Section 12.4.7, “Line Control Register (ULCR).”
0x504	0x0_4504	x	UART1 MODEM control register (UMCR)	Controls the interface with the external attached peripheral device on the UART bus. See Section 12.4.8, “MODEM Control Register (UMCR).”
0x505	0x0_4505	x	UART1 line status register (ULSR)	Allows software to monitor the status of data transfer on the UART bus. This register is read only. See Section 12.4.9, “Line Status Register (ULSR).”
0x506	0x0_4506	x	UART1 MODEM status register (UMSR)	Allows software to monitor the status of the MODEM (or external peripheral device) clear to send ($\overline{\text{CTS}}$) signal. See Section 12.4.10, “MODEM Status Register (UMSR).”
0x507	0x0_4507	x	UART1 scratch register (USCR)	Used for debugging software code or the DUART hardware. This register does not effect the operation of the DUART. See Section 12.4.11, “Scratch Register (USCR).”
0x510	0x0_4510	x	UART1 DMA status register (UDSR)	Returns the transmitter and receiver status, or FIFO status if in FIFO mode, and provides the ability to assist DMA data operations. This register is read only. See Section 12.4.13, “DMA Status Register (UDSR).”
0x511	0x0_4511	x	UART1 DUART configuration register (DCR)	Allows the ability to set the DUART to four-signal UART mode or 4-signal DUART mode. See Section 12.4.14, “DUART Configuration Register (DCR).”
0x600	0x0_4600	0	UART2 receiver buffer register (URBR)	Contains the data received from the external device on the UART bus. This register is read only. See Section 12.4.1, “Receiver Buffer Register (URBR).”

Table 12-2. DUART Register Summary (continued)

PCI Memory Offset	Local Memory Offset	Divisor Latch Access Bit ULCR[DLAB]	Register Name	Register Description
0x600	0x0_4600	0	UART2 transmitter holding register (UTHR)	A write to this register causes the UART device to transfer 5 to 8 data bits on the UART bus in the format set up int he ULCR. This register is write only. See Section 12.4.3, “Transmitter Holding Register (UTHR).”
0x600	0x0_4600	1	UART2 divisor least significant byte register (UDLB)	Combines with the UDMB to create the divisor of the DUART clock. See Section 12.4.2, “Divisor Most and Least Significant Byte Registers (UDMB and UDLB).”
0x601	0x0_4601	0	UART2 interrupt enable register (UIER)	Allows the ability to mask specific UART interrupts to the processor core or the PCI bus. See Section 12.4.4, “Interrupt Enable Register (UIER).”
0x601	0x0_4601	1	UART2 divisor most significant byte register (UDMB)	Combines with the UDLB to create the divisor of the DUART clock. See Section 12.4.2, “Divisor Most and Least Significant Byte Registers (UDMB and UDLB).”
0x602	0x0_4602	0	UART2 interrupt ID register (UIIR)	Indicates when and what type of interrupt is pending. This register is read only. See Section 12.4.5, “Interrupt ID Register (UIIR).”
0x602	0x0_4602	0	UART2 FIFO control register (UFCR)	Enables and clears the receiver and transmitter FIFOs, sets a receiver FIFO trigger level, and selects type of DMA signalling. See Section 12.4.6, “FIFO Control Register (UFCR).”
0x602	0x0_4602	1	UART2 alternate function register (UAFR)	Enables software to concurrently write to both UART1 and UART2 registers with the same write operation. The UAFR also provides a means for the MPC8245's performance monitor to track the baud clock. See Section 12.4.12, “Alternate Function Register (UAFR).”
0x603	0x0_4603	x	UART2 line control register (ULCR)	Specifies the data format for the UART bus and sets the divisor latch access bit (DLAB). See Section 12.4.7, “Line Control Register (ULCR).”
0x604	0x0_4604	x	UART2 MODEM control register (UMCR)	Controls the interface with the external attached peripheral device on the UART bus. See Section 12.4.8, “MODEM Control Register (UMCR).”
0x605	0x0_4605	x	UART2 line status register (ULSR)	Allows software to monitor the status of data transfer on the UART bus. This register is read only. See Section 12.4.9, “Line Status Register (ULSR).”
0x606	0x0_4606	x	UART2 MODEM status register (UMSR)	Allows software to monitor the status of the MODEM (or external peripheral device) clear to send ($\overline{\text{CTS}}$) signal. See Section 12.4.10, “MODEM Status Register (UMSR).”

Table 12-2. DUART Register Summary (continued)

PCI Memory Offset	Local Memory Offset	Divisor Latch Access Bit ULCR[DLAB]	Register Name	Register Description
0x607	0x0_4607	x	UART2 scratch register (USCR)	Used for debugging software code or the DUART hardware. This register does not effect the operation of the DUART. See Section 12.4.11, “Scratch Register (USCR).”
0x610	0x0_4610	x	UART2 DMA status register (UDSR)	Returns the transmitter and receiver status, or FIFO status if in FIFO mode, and provides the ability to assist DMA data operations. This register is read only. See Section 12.4.13, “DMA Status Register (UDSR).”
0x611	0x0_4611	x	UART2 DUART configuration register (DCR)	Allows the ability to set the DUART to four-signal UART mode or 4-signal DUART mode. See Section 12.4.14, “DUART Configuration Register (DCR).”

12.2 DUART Operation

The communication channel provides a full-duplex asynchronous receiver and transmitter using an operating frequency derived from the SDRAM_CLK*n*.

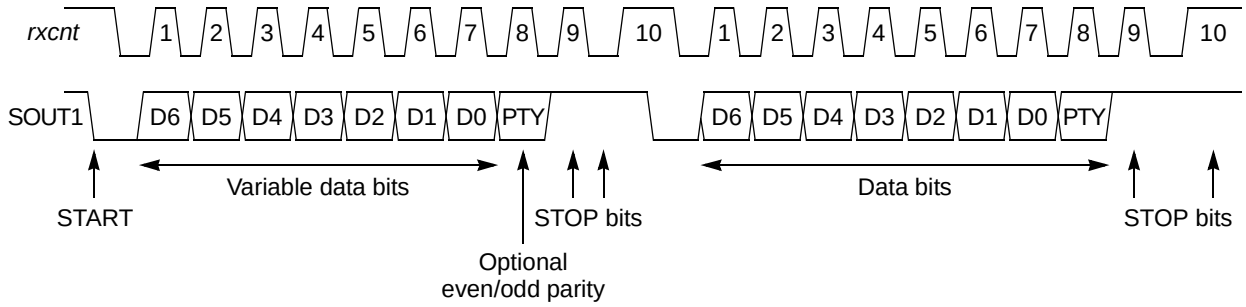
The transmitter accepts parallel data from the processor core or external PCI master with a write to the transmitter holding register (UTHR). The data is placed directly into an internal transmitter shift register or into the transmitter FIFO in FIFO mode (see Section 12.2.5, “FIFO Mode”). The transmitting registers convert the data to a serial bit stream, inserting the appropriate START, STOP, and optional parity bits. Finally, the registers output a composite serial data stream on the channel transmitter serial data output (SOUT). The transmitter status may be polled or interrupt-driven.

The receiver accepts serial data on the channel receiver serial data input (SIN), converts the data into parallel format, and checks for a START, STOP, and parity bits. The receiver removes the START, STOP, parity bits and then transfers the assembled character from the receiver buffer, or receiver FIFO in FIFO mode, to the processor core or PCI bus. This transfer is in response to a read of the UART receiver buffer register (URBR). The receiver status may be polled or interrupt-driven.

12.2.1 Serial Interface

The UART bus is a serial, full-duplex, point-to-point bus. Only two devices are attached to the same signals, and address or arbitration bus cycles are not needed.

Figure 12-3 shows the protocol of a UART bus interface transaction.



Two 7-bit data transmissions with parity and 2-bit STOP transactions

Figure 12-3. UART Bus Interface Transaction Protocol Example

A standard UART bus transfer is composed of three or four parts:

1. START bit
2. Data transfer (least significant bit is first data bit on the bus)
3. Parity bit (optional)
4. STOP bit

An internal logic sample signal, *rxcnt*, uses the frequency of the baud-rate generator to track the bits on SOUT.

The four parts, the baud-rate generator, and other related topics are described in the following sections.

12.2.1.1 START Bit

A write to the transmitter holding register (UTHR) initiates the generation of a START bit on the SOUT signal. As shown in Figure 12-3, a START bit is defined as a logic 0. This signal denotes the beginning of a new data transfer which is limited to the bit length programmed in the UART line control register (ULCR).When the bus is idle, SOUT is high.

12.2.1.2 Data Transfer

Each data transfer contains 5, 6, 7, or 8 bits of data. The ULCR data bit length for the transmitter and receiver UART devices must agree before a transfer begins to avoid causing a parity or framing error. A transfer begins when UTHR is written. At that time, a START bit is generated followed by 5 to 8 of the data bits written to the UTHR, from the least significant to the most significant. After the parity and STOP bits, a new data transfer can begin if new data is written to the UTHR.

12.2.1.3 Parity Bit

Using even, odd, no parity, or stick parity are all optional (see Table 12-12). Both the receiver and transmitter parity definition must agree before attempting to transfer data. A parity error occurs if an unexpected parity value is detected when receiving data (see Table 12-15).

12.2.1.4 STOP Bit

The transmitter device generates a STOP bit to end the write transfer. The STOP bit is always high. The user can program the length of the STOP bits in the ULCR. Both the receiver and transmitter STOP bit length must agree before attempting to transfer data. A framing error could occur if an invalid STOP bit is detected.

12.2.2 Baud-Rate Generator Logic

Each UART contains an independent programmable baud-rate generator. Each is capable of taking the SDRAM_CLK*n* input and dividing the input by any divisor from 1 to 2^{16} - 1.

The baud rate is defined as the number of bits per second that can be sent over the UART bus. The output frequency of the baud-rate generator is 16 times the baud rate. Therefore, baud rate = (1/16) x (SDRAM_CLK*n* frequency/divisor value).

The divisor value is determined by two 8-bit registers, UART divisor most significant byte register (UDMB) and UART divisor least significant byte register (UDLB), to form a 16-bit binary number. When loading either of the divisor latches, a 16-bit baud-rate counter is loaded.

The divisor latches must be loaded during initialization to ensure proper operation of the baud-rate generator. Both UART devices on the same bus must be programmed for the same baud-rate before starting a transfer.

Enabling the UAFR[BO] bit can cause the baud clock to be passed to the performance monitor. This action can be used to determine baud rate error. See Section 16.4.1, “Determining UART Baud Rate,” for more information.

12.2.3 Local Loop Back Mode

The local loop back mode is provided for diagnostic testing. The data written to UTHR can be read from receiver buffer register (URBR) of the same UART. The MODEM control register UMCR[RTS] is tied to MODEM status register UMSR[CTS]. The transmitter SOUT is set to a logic 1 and the receiver SIN is disconnected. The output of the transmitter shift register is “looped back” into the receiver shift register input. The $\overline{\text{CTS}}$ (input pin) is disconnected, $\overline{\text{RTS}}$ is internally connected to $\overline{\text{CTS}}$, and $\overline{\text{RTS}}$ (output pin) becomes inactive. In this diagnostic mode, data that is transmitted is immediately received. In local loop back

mode, the processor core or external PCI master can verify the transmit and receive data paths of the DUART.

NOTE

In local loop back mode, the transmit/receive interrupts are fully operational and can be controlled by the interrupt enable register (UIER).

12.2.4 Errors

The following sections describe framing, parity, and overrun errors that may occur while data is transferred on the UART bus. Each of the error bits is usually reset when the line status register (ULSR) is read.

12.2.4.1 Framing Error

A framing error occurs and ULSR[FE] is set when an invalid STOP bit is detected. Only the first STOP bit is checked. In the FIFO mode, ULSR[FE] is set when the character at the top of the FIFO detects a framing error. An attempt to re-synchronize occurs after a framing error. The UART assumes that the framing error (which was caused a logic 0 being read when a logic 1 (STOP) was expected) was due to a STOP bit overlapping with the next START bit. ULSR[FE] is reset when ULSR is read or when a new character is loaded into the URBR from the receiver shift register.

12.2.4.2 Parity Error

A parity error occurs and ULSR[PE] is set when unexpected parity values are encountered while receiving data. In FIFO mode, ULSR[PE] is set when the character with the error is at the top of the FIFO (the next character to be sent to the processor core or on the PCI bus with a URBR read). ULSR[PE] is reset when ULSR is read or when a new character is loaded into the URBR.

12.2.4.3 Overrun Error

An overrun error occurs and ULSR[OE] is set when a new (overwriting character) STOP bit is detected and the old character is lost. In FIFO mode, ULSR[OE] is set after the receiver FIFO is full (despite the receiver FIFO trigger level setting) and a new character is received into the internal receiver shift register. Data in the FIFO is not overwritten; only the shift register data is overwritten, and the interrupt occurs immediately. ULSR[OE] is reset when ULSR is read.

12.2.5 FIFO Mode

The UARTs use an alternate mode (FIFO mode) to relieve the processor core of excessive software overhead. The FIFO control register (UFCR) enables and clears the receiver and transmitter FIFOs and sets the FIFO receiver trigger level UFCR[RTL] to control the received data available interrupt UIER[ERDAI].

The UFCR also selects the type of DMA signalling. The UDSR[RXRDY] indicates the status of the receiver FIFO. DMA status registers UDSR[TXRDY] indicate when the transmitter FIFO is full. When in FIFO mode, data written to UTHR is placed into the transmitter FIFO. The first byte written to UTHR is the first byte onto the UART bus.

12.2.5.1 FIFO Interrupts

The UIER[ERDAI] is set when a time-out interrupt occurs in FIFO mode. A receive data time-out and a mask interrupt of the UIER[ERDAI] occur. See Table 12-7 for more details on interrupt enables.

The interrupt ID register (UIIR) indicates if the FIFOs are enabled. Interrupt ID3 UIIR[IID3] bit is set only to 1 for FIFO mode interrupts. The character time-out interrupt occurs when no characters have been removed from or input to the receiver FIFO during the last four character times and at least one character is in the receiver FIFO during this time. The character time-out interrupt of the UIIR[IID] bits is reset when the URBR is read. See Table 12-9 for more information.

The UIIR[FE] bits indicate if FIFO mode is enabled.

12.2.5.2 DMA Mode Select

The UDSR[RXRDY] bit reflects the status of the receiver FIFO or URBR. In mode 0, UFCR[DMS] = 0, UDSR[RXRDY] is cleared when at least one character is in the receiver FIFO or URBR and is set when there are no more characters in the receiver FIFO or URBR. This occurs regardless of the UFCR[FEN] bit. In mode 1, UFCR[DMS] = 1 and UFCR[FEN] =1, UDSR[RXRDY] is cleared when the trigger level or a time-out has been reached and is set when no additional characters remain in the receiver FIFO.

The UDSR[TXRDY] bit reflects the status of the transmitter FIFO or UTHR. In mode 0, UFCR[DMS] =0, UDSR[TXRDY] is cleared when no characters are in the transmitter FIFO or UTHR and is set after the first characters loaded into the transmitter FIFO or UTHR. This occurs regardless of the UFCR[FEN] bit. In mode 1, UFCR[DMS] = 1 and UFCR[FEN] =1, UDSR[TXRDY] is cleared when no characters are in the transmitter FIFO or UTHR and is set when the transmitter FIFO is full.

See the description of the USDR[RXRDY] and USDR[TXRDY] bits in Table 12-19.

12.2.6 Interrupt Control Logic

When the DUART configuration register's PCI interrupt bit, DCR[IRQSx], is set to 0, an internal interrupt request signal is directed to the local processor by notifying the interrupt controller PIC of an interrupt condition. An interrupt is active when DUART interrupt ID register bit 0, UIIR[0], is active low. The interrupt enable register (UIER) masks specific interrupt types. For more details see the description of UIER in Section 12.4.4, "Interrupt Enable Register (UIER)."

When DCR[IRQSx] is 0, the interrupt priority of the UART module is programmed in the PIC, which is external to the UART module. When the UART has an active interrupt, and the interrupt's priority is the highest of all active system interrupts and the PIC task register, the interrupt is sent to the local processor through the PIC unit. PIC returns the UART's vector ID as programmed in PIC's UART interrupt vector source register in response to a read acknowledge. Refer to Chapter 11, "Programmable Interrupt Controller (PIC) Unit," for more information.

When DCR[IRQSx] is set to 1, the interrupt is routed to the PCI bus. Also, each UART passes a status bit, which is the inverted value of UIIR[0], to the PCI interrupt status register. Refer to Chapter 7, "PCI Bus Interface," for details.

When the interrupts are disabled in UIER, polling software can not use UIIR[0] to determine if the UART is ready for service. The software must monitor the appropriate bits in the line status (ULSR) and/or the MODEM status (UMSR) registers. UIIR[0] can be used for polling if the interrupts are enabled in UIER, the DCR[IRQSx] bit is set to 0, and PIC's UART interrupt is masked.

12.3 DUART Initialization Sequence

A typical sequence of events must occur before using DUART with processor core accesses.

- If the processor core memory management unit (MMU) is on, all DUART registers must be located in a cache-inhibited area.
- Set the Embedded Utilities Memory Block (see chapter 17).
- The DUART registers in this chapter are in little endian format. If your system is in big endian mode, ensure that the bytes are appropriately swapped by software.

Resetting puts the DUART registers to a default state. Before the interface can transfer serial data, Motorola recommends the following initialization steps:

1. Update the PIC DUART channel interrupt vector source registers.
2. Update the DUART configuration register (DCR).
3. Set data attributes and control bits in the ULCR, UFCR, UAFR, UMCR, UDLB, and UDMB.

4. Set the data attributes and control bits of the external MODEM or peripheral device.
5. Set the interrupt enable register (UIER).
6. To start a write transfer, write to the UTHR.
7. Poll UIIR if the PIC unit's interrupt is masked, or the PIC unit is inactive, and UDCR[IRQSx] is set to 0.

12.4 Programming Model

Fourteen registers in each UART interface are used for configuration, control, and status and one register with FIFO mode support. Each register is 8 bits wide.

NOTE

Even though reserved fields return 0, do not assume that this result will occur. Reserved bits should always be written with the value returned when the bits are read. Program the register by reading the value, modifying the appropriate fields, and writing back the value.

12.4.1 Receiver Buffer Register (URBR)

The URBRs, which are read only registers, contain the data received from the external device on the UART bus. The URBRs are read only registers. When read in FIFO mode, the URBRs returns the first byte received. URBR returns the data in the order the data is received from the transmitter, except when an overrun error occurs. Refer to Section 12.4.9, "Line Status Register (ULSR)," for a description of overrun errors.

Figure 12-4 shows the data bits in the URBRs.

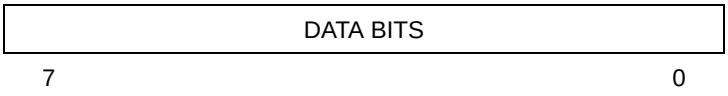


Figure 12-4. Receiver Register (URBR)

Table 12-3 describes the bit settings for the URBRs.

Table 12-3. Bit Settings for URBR—Offsets 0x500, 0x600

BIT	NAME	RESET VALUE	R/W	DESCRIPTION
7–0	DATA	All 0s	R	Data received from the transmitter on the UART bus. Bit 0 is the least significant bit and the first bit to be received; bit 7 is the most significant bit and the last to be received.

12.4.2 Divisor Most and Least Significant Byte Registers (UDMB and UDLB)

UDMB and UDLB combine to create the divisor that divides the input clock into the DUART. Together, the minimum setting allowed is decimal value 1. The output frequency of the baud generator is 16 times the baud rate, divisor value = (frequency input)/(baud rate x 16). Table 12-5 gives examples of the resulting baud-rate when the input clock is at a certain frequency.

Figure 12-5 shows the bits in the divisor registers.

Figure 12-5. Divisor Register (UDMB, UDLB)

Table 12-4 describes the bit settings for the UDMBs and UDLBs.

Table 12-4. Bit Settings for Divisor Register UDMB, UDLB—Offsets 0x501/0x601, 0x500/0x600

Bit	Name	Reset Value	R/W	Description
15–8	UDMB	All 0s	R/W	Divisor most significant byte value
7–0	UDLB	All 0s	R/W	Divisor least significant byte value If UDMB=0, the minimum value for UDLB is 1.

Table 12-5 shows examples of baud rates at various frequencies.

Table 12-5. Baud Rate Examples

Baud Rate (Dec)	Divisor (Dec)	Input Clock Frequency (MHz)	Percent Error (Dec)
9600	434	66	0.0064
19200	217	66	0.0064
38400	109	66	0.454
56000	74	66	0.547
128000	33	66	1.376
256000	16	66	1.725
9600	651	100	0.0064
19200	326	100	0.1472
38400	163	100	0.1472
56000	112	100	0.352

Table 12-5. Baud Rate Examples (continued)

Baud Rate (Dec)	Divisor (Dec)	Input Clock Frequency (MHz)	Percent Error (Dec)
128000	49	100	0.352
256000	24	100	1.725

12.4.3 Transmitter Holding Register (UTHR)

A write to UTHR, a write only register, causes the UART device to transfer 5 to 8 data bits on the UART bus in the format setup in the ULCR. In FIFO mode, data written to UTHR is placed into the FIFO. The first byte written to UTHR is the first byte onto the UART bus.

Figure 12-6 shows the data bits in the UTHRs.

Figure 12-6. Transmitter Holding Register (UTHR)

Table 12-6 describes the bit settings for the UTHRs.

Table 12-6. Bit Settings for UTHR—Offsets 0x500, 0x600

Bit	Name	Reset Value	R/W	Description
7–0	DATA	All 0s	R	Data written to the external device receiver on the UART bus. Bit 0 is the least significant bit, and the first data bit to be transmitted; bit 7is the most significant bit, and the last data bit to be transmitted.

12.4.4 Interrupt Enable Register (UIER)

The UIER gives the user the ability to mask specific UART interrupts to the processor core or PCI bus.

Figure 12-7 shows the bits in the UIERs.

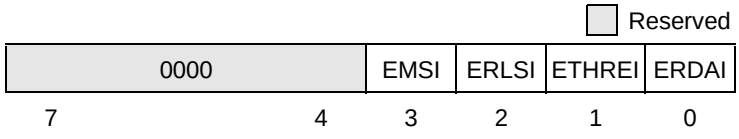


Figure 12-7. Interrupt Enable Register (UIER)

Table 12-7 describes the bit settings for the UIERs.

Table 12-7. Bit Settings for UIER—Offsets 0x501, 0x601

Bit	Name	Reset Value	R/W	Description
7–4	—	All 0s	R	Reserved
3	EMSI	0	R/W	Enable MODEM status interrupt 0 Mask interrupts to the processor core, through the PIC unit, or PCI bus due to UMSR[DCTS] bit being set. 1 Enable interrupts to report to the processor core, through the PIC unit, or PCI bus when clear to send bit in the UMSR changes state.
2	ERLSI	0	R/W	Enable receiver line status interrupt 0 Mask interrupts concerning receive data errors. 1 Interrupt is generated and sent through the PIC unit to the processor core or PCI bus due to ULSRs overrun error, parity error, framing error, or a break interrupt.
1	ETHREI	0	R/W	Enable transmitter holding register empty interrupt 0 Mask interrupt when ULSR[THRE] is set. 1 Interrupt processor core, through the PIC unit, or PCI bus when ULSR[THRE] bit is set.
0	ERDAI	0	R/W	Enable received data available interrupt 0 Mask interrupt when new receive data is available or receive data time-out has occurred. 1 Interrupt processor core, through the PIC unit, or PCI bus when a new data character is received from the external device and/or a time-out interrupt in the FIFO mode.

12.4.5 Interrupt ID Register (UIIR)

The UIIR, a read-only register, indicates when an interrupt is pending from the UART and what type of interrupt is active. UIIR also gives status on if the FIFOs are enabled.

The DUART prioritizes interrupts into four levels and records these in UIIR. The following four levels of interrupt conditions are in priority order:

1. Receiver line status
2. Received data ready
3. Transmitter holding register empty
4. MODEM status

When the processor core reads the UIIR, the associated DUART serial channel freezes all interrupts and indicates the highest priority pending interrupt to the PIC unit. While this access is occurring, the associated DUART serial channel records new interrupts, but does not change the current indication of the serial channel until the access is complete.

Figure 12-8 shows the bits in the UIIRs.

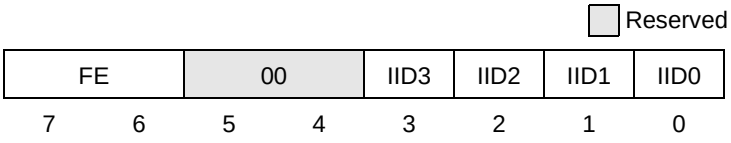


Figure 12-8. Interrupt ID Register (UIIR)

Table 12-8 describes the bit settings for the UIIRs.

Table 12-8. Bit Settings for UIIR—Offsets 0x502, 0x602

Bit	Name	Reset Value	R/W	Description
7–6	FE	00	R	FIFO's enabled. Reflects the setting of UFCR[FEN]. When UFCR[FEN] is set, both FIFO's are enabled and the UIIR[FE] bits are set. At that moment there is no way to disable a transmit FIFO while the receive FIFO is enabled or vice versa. The FIFO's are either both on or both off.
5–4	—	00	R	Reserved
3	IID3	0	R	Interrupt ID bit that is only set to 1 along with IID2 when a timeout interrupt is pending for FIFO mode.
2–1	IID2–1	0	R	Interrupt ID bits used to identify the highest priority pending as indicated in Table 12-9. Settings not mentioned are reserved.
0	IID0	1	R	Interrupt ID bit that indicates when an interrupt is pending. 0 The UART has an active interrupt ready to be serviced. 1 No interrupt is pending.

Table 12-9 summarizes the IID bits of the UIIRs.

Table 12-9. UIIR IID Bits Summary

IID Bits IID[3–0]	Priority Level	Interrupt Type	Interrupt Description	How To Reset Interrupt
0b0001	—	—	—	—
0b0110	Highest	Receiver Line Status	Overrun error, parity error, framing error, or break interrupt	Reading the line status register
0b0100	Second	Received Data Available	Receiver data available or Trigger Level reached in FIFO mode	Reading the receiver buffer register or the FIFO drops below the Trigger Level
0b1100	Second	Character Time-out	No characters have been removed from or input to the receiver FIFO during the last 4 character times and there is at least one character in the receiver FIFO during this time	Reading the receiver buffer register

Table 12-9. UIIR IID Bits Summary (continued)

IID Bits IID[3–0]	Priority Level	Interrupt Type	Interrupt Description	How To Reset Interrupt
0b0010	Third	UTHR empty	Transmitter holding register is empty	Reading the UIIR or writing in to the UTHR
0b0000	Fourth	MODEM status	Clear to send input pin changed since last read of UMSR	Reading the UMSR

12.4.6 FIFO Control Register (UFCR)

The UFCR, a write-only register, enables and clears the receiver and transmitter FIFOs, sets a receiver FIFO trigger level to control the received data available interrupt, and selects the type of DMA signalling.

When the UFCR bits are written to, the FIFO enable must be set to 1 or else the UFCR bits are not programmed. When changing from FIFO mode to 16450 mode (non-FIFO mode) and vice versa, data is automatically cleared from the FIFOs.

After all the bytes in the receiver FIFO are cleared, the receiver internal shift register is not cleared. When the bytes are cleared in the transmitter FIFO, the transmitter internal shift register is not cleared. Both TFR and RFR are self-clearing bits.

Figure 12-9 shows the bits in the UFCRs.

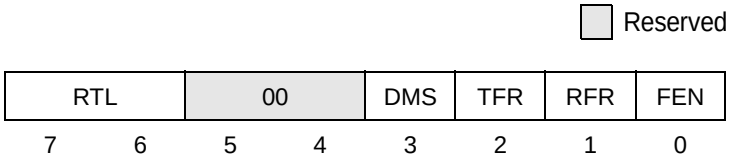


Figure 12-9. FIFO Control Register (UFCR)

Table 12-10 describes the bit settings for the UFCRs.

Table 12-10. Bit Settings for UFCR—Offsets 0x502, 0x602

Bit	Name	Reset Value	R/W	Description
7–6	RTL	00	W	Receiver Trigger Level. A received data available interrupt occurs when UIER[ERDAI] is set the number of bytes in the receiver FIFO equals the designated interrupt trigger level as specified in Table 12-11.
5–4	—	00	W	Reserved

Table 12-10. Bit Settings for UFCR—Offsets 0x502, 0x602 (continued)

Bit	Name	Reset Value	R/W	Description
3	DMS	0	W	DMA Mode Select 0 UDSR[RXRDY] and UDSR[TXRDY] bits are in mode 0. 1 UDSR[RXRDY] and UDSR[TXRDY] bits are in mode 1 if UFCR[FEN] = 1. Refer is Section 12.2.5.2, “DMA Mode Select.” See the description of the UDSR[RXRDY] and UDSR[TXRDY] bits in Table 12-19.
2	TFR	0	W	Transmitter FIFO Reset 1 Clear all bytes in the Transmitter FIFO and reset the FIFO counter/pointer to 0
1	RFR	0	W	Receiver FIFO Reset 1 Clear all bytes in the Receiver FIFO and reset the FIFO counter/pointer to 0
0	FEN	0	W	FIFO Enable 0 FIFOs are disabled and cleared. 1 Enables the transmitter and receiver FIFOs.

Table 12-11 shows receiver trigger levels for UFCRs.

Table 12-11. UFCR’s Receiver Trigger Level

UFCR[RTL]	Receiver FIFO Trigger Level
0b00	1 byte
0b01	4 bytes
0b10	8 bytes
0b11	14 bytes

12.4.7 Line Control Register (ULCR)

The ULCR specifies the data format for the UART bus and sets the divisor latch access bit ULCR[DLAB], which controls the ability to access divisor latch least and most significant bit registers and alternate function register.

After initializing the ULCR, the software should not re-write the ULCR when valid transfers on the UART bus are active. The software should not re-write the ULCR until the last STOP bit has been received and no new characters are being transferred on the bus.

The stick parity bit, ULCR[SP], assigns a set parity value for the parity bit time slot sent on the UART bus. The set value is defined as mark parity (logic 1) or space parity (logic 0). ULCR[PEN] and ULCR[EPS] help determine the set parity value. See Table 12-13 for more information. ULCR[NSTB], defines the number of STOP bits to be sent at the end of the data transfer. The receiver checks the first STOP bit only, regardless of the number of STOP bits selected. Word length select bits (1 and 0) defines the number of data bits that is transmitted or received as a serial character. The data bit length does not include START, parity, and STOP bits.

Figure 12-10 shows the bits in the ULCRs.

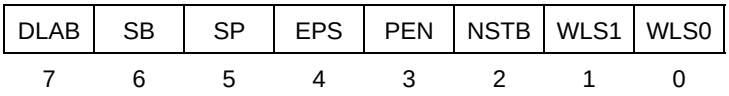


Figure 12-10. Line Control Register (ULCR)

Table 12-12 describes the bit settings for the ULCRs.

Table 12-12. Bit Settings for ULCR—Offsets 0x503, 0x603

Bit	Name	Reset Value	R/W	Description
7	DLAB	0	R/W	Divisor latch access bit 0 Access to all registers except UDLB, UAFR, and UDMB. 1 Ability to access divisor latch least and most significant bit registers and alternate function register (UAFR).
6	SB	0	R/W	Set Break 0 Send normal UTHR data onto the serial output (SOUT) signal. 1 Force logic 0 to be on the SOUT signal. Data in the UTHR is not effected.
5	SP	0	R/W	Stick Parity 0 Stick Parity is disabled. 1 And if PEN and EPS are a logic 1, a Space Parity is selected. And if PEN=1, EPS=0, a Mark Parity is selected. See Table 12-13.
4	EPS	0	R/W	Even Parity Select 0 And PEN=1 and SP=0 then odd parity is selected. 1 And PEN=1 and SP=0 then even parity is selected. See Table 12-13.
3	PEN	0	R/W	Parity Enable 0 No parity generation and check. 1 Generate parity bit as a transmitter, and check parity as a receiver. See Table 12-13.
2	NSTB	0	R/W	Number of STOP Bits 0 One STOP bit is generated in the transmitted data. 1 When a 5-bit data length is selected, 1 1/2 STOP bits are generated. When either a 6-, 7-, or 8-bit word length is selected, two STOP bits are generated.
1–0	WLS1 WLS0	0	R/W	Word Length Select Bits 1 and 0 For WLS[1-0] value of: 00 The character length is 5 data bits 01 The length is 6-bits 10 The length is 7-bits 11 The length is 8-bits

Table 12-13 describes how parity is selected using the PEN, SP, and EPS bits in the ULCR.

Table 12-13. Parity Selection Using ULCR[PEN], ULCR[SP], and ULCR[EPS]

PEN	SP	EPS	Parity Selected
0	0	0	No parity
0	0	1	No parity
0	1	0	No parity
0	1	1	No parity
1	0	0	Odd parity
1	0	1	Even parity
1	1	0	Mark parity
1	1	1	Space parity

12.4.8 MODEM Control Register (UMCR)

The UMCR controls the interface with the external attached peripheral device on the UART bus. The UMCR[RTS] feature is not functional in the special 4-pin DUART mode.

Figure 12-11 shows the bits in the UMCRs.

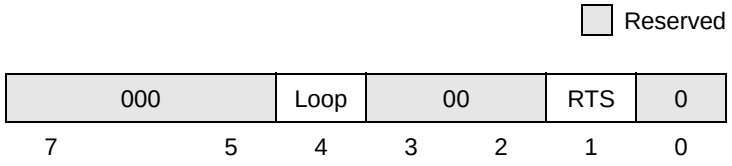


Figure 12-11. Modem Control Register (UMCR)

Table 12-14 describes the bit settings for the UMCRs.

Table 12-14. Bit Settings for UMCR—Offsets 0x504, 0x604

Bit	Name	Reset Value	R/W	Description
7–5	—	000	R/W	Reserved
4	Loop	0	R/W	Local loop back mode 1 Functionally, the data written to UTHR can be read from URBR of the same UART, and UMCR[RTS] is tied to UMSR[CTS].
3–2	—	00	R	Reserved
1	RTS	0	R/W	Ready to send 0 Drive UART output pin $\overline{\text{RTS}}$ inactive. 1 Drive UART $\overline{\text{RTS1}}$ output pin active low. Inform external MODEM or peripheral that the UART is ready for sending/receiving data.
0	—	0	R	Reserved

12.4.9 Line Status Register (ULSR)

The ULSR, a read only register, monitors the status of the data transfer on the UART bus.

Software should read the ULSR first and then read URBR to isolate the status bits with the proper character received from the UART bus.

Figure 12-12 shows the bits in the ULSRs.

Figure 12-12. Line Status Register (ULSR)

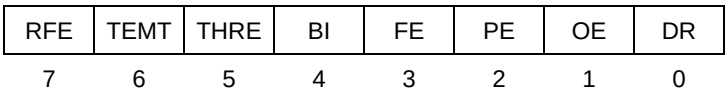


Table 12-15 describes the bit settings for the ULSRs.

Table 12-15. Bit Settings for ULSR—Offsets 0x505, 0x605

Bit	Name	Reset Value	R/W	Description
7	RFE	0	R	Receiver FIFO error. 0 This bit is cleared when there are no errors in the receiver FIFO or on a read of the ULSR with no remaining receiver FIFO errors. 1 Set to one when one of the characters in the receiver FIFO encounters an error (framing, parity, or break interrupt).
6	TEMT	1	R	Transmitter empty 0 Either or both the UTHR or the internal transmitter shift register has a data character. In FIFO mode, a data character is in the transmitter FIFO or the internal transmitter shift register. 1 Both the UTHR and the internal transmitter shift register are empty. In FIFO mode, both the transmitter FIFO and the internal transmitter shift register is empty.
5	THRE	1	R	Transmitter holding register empty 0 The UTHR is not empty. 1 Data character has transferred from the UTHR into the internal transmitter shift register. In FIFO mode, the transmitter FIFO contains no data character.
4	BI	0	R	Break interrupt 0 This bit is cleared when the ULSR is read or when a valid data transfer is detected (i.e., good STOP bit is received). 1 Received data of logic 0 for more than START bit + Data bits + Parity bit + one STOP bits length of time. A new character is not loaded until SIN returns to the mark state (logic 1) and a valid START is detected. In the FIFO mode, the particular zero character is encountered in the FIFO (the zero character is at the top of the FIFO). In FIFO mode, only one zero character is stored. Note that after the ULSR is read, ULSR[BI] immediately is set if bus remains zero and no mark state followed by a valid new character has been detected.

Table 12-15. Bit Settings for ULSR—Offsets 0x505, 0x605 (continued)

Bit	Name	Reset Value	R/W	Description
3	FE	0	R	Framing error 0 This bit is cleared when ULSR is read or when a new character is loaded into the URBR from the receiver shift register. 1 Invalid STOP bit for receive data (the first STOP bit is only checked). In the FIFO mode, the particular character that detected a framing error is encountered in the FIFO (that is the character at the top of the FIFO). An attempt to resynchronize will occur after a framing error. The UART will assume that the framing error (due to a logic 0 being read when a logic 1 (STOP) was expected) was due to a STOP bit overlapping with the next START bit, so it assumes this logic 0 sample is a true START bit and then will receive the following new data.
2	PE	0	R	Parity error 0 This bit is cleared when ULSR is read or when a new character is loaded into the URBR. 1 Unexpected parity value encountered when receiving data. In FIFO mode, the character with the error is at the top of the FIFO (the next character to be sent to the processor core or on the PCI bus with a URBR read).
1	OE	0	R	Overrun error 0 This bit is cleared when ULSR is read. 1 Before the processor core or PCI bus device reads the URBR, the URBR is overwritten with a new character. The old character is lost. In FIFO mode, the receiver FIFO is full (despite the receiver FIFO trigger level setting) and a new character has been received into the internal receiver shift register. The old character is overwritten by the new character. Data in the receiver FIFO is not overwritten.
0	DR	0	R	Data ready 0 This bit is cleared when URBR is read or when all of the data in the receiver FIFO is read by the processor core or a PCI bus device. 1 A character has been received in the URBR or the receiver FIFO.

12.4.10 MODEM Status Register (UMSR)

The UMSR tracks the status of the MODEM (or external peripheral device) clear to send ($\overline{\text{CTS}}$) pin signal.

Figure 12-13 shows the bits in the UMSRs.

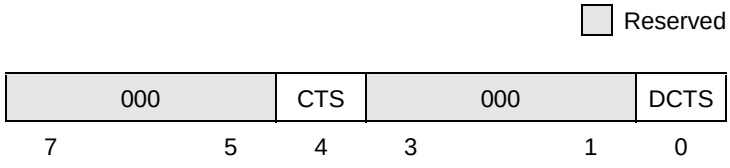


Figure 12-13. Modem Status Register (UMSR)

Table 12-16 describes the bit settings for the UMSRs.

Table 12-16. Bit Settings for UMSR—Offsets 0x506, 0x606

Bit	Name	Reset Value	R/W	Description
7–5	—	0	R	Reserved
4	CTS	0	R	Clear to send The inverted value of the $\overline{\text{CTS}}$ input pin from the external peripheral device. 1 $\overline{\text{CTS}}$ pin is active. The MODEM or peripheral device is ready for data transfers. UMSR[CTS] is always read as inactive in Special 4-pin DUART mode.
3–1	—	0	R	Reserved
0	DCTS	0	R	Delta clear to send 1 Since the last read of UMSR[CTS] the $\overline{\text{CTS}}$ pin value has changed. Causes an interrupt if UIER[EMSI] is on. 0 No change on the $\overline{\text{CTS}}$ pin since the last read of UMSR[CTS].

12.4.11 Scratch Register (USCR)

The USCR is for debugging software code or the DUART hardware. The USCR does not affect the operation of the DUART.

Figure 12-14 shows the data bits in the USCRs.

Figure 12-14. Scratch Register (USCR)

Table 12-17 describes the bit settings for the USCRs.

Table 12-17. Bit Settings for USCR—Offsets 0x507, 0x607

Bit	Name	Reset Value	R/W	Description
7–0	DATA	0x0	R/W	Register made available for the writing of any 8-bit data.

12.4.12 Alternate Function Register (UAFR)

The UAFR gives software the ability to write concurrently to both UART1 and UART2 registers with the same write operation and also provides a means for the MPC8245's performance monitor to track the baud clock.

Figure 12-15 shows the bits in the UAFRs.

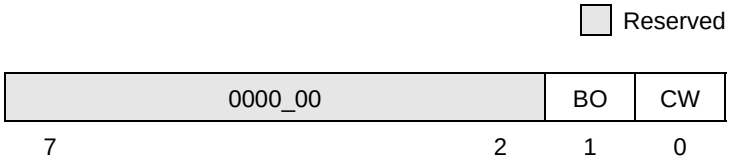


Figure 12-15. Alternate Function Register (UAFR)

Table 12-18 describes the bit settings for the UAFRs.

Table 12-18. Bit Settings for UAFR—Offsets 0x502, 0x602

Bit	Name	Reset Value	R/W	Description
7–3	—	All 0s	R	Reserved
1	BO	0	R/W	Baud Clock Select 0 The baud clock is not passed to the performance monitor. 1 The baud clock is passed to the performance monitor.
0	CW	0	R/W	Concurrent Write Enable 0 Disable writing to both UART1 and UART2 1 Enables concurrent writes to corresponding UART registers. A write to a register in UART1 is also a write to the corresponding register in UART2 and vice versa.

12.4.13DMA Status Register (UDSR)

The UDSR, a read only register, returns transmitter and receiver FIFO status. UDSR also provides the ability to assist DMA data operations to and from the FIFOs.

Figure 12-16 shows the bits in the UDSR.

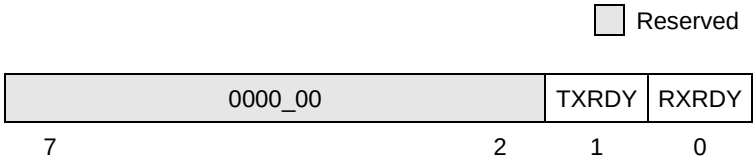


Figure 12-16. DMA Status Register (UDSR)

Table 12-19 describes the bit settings for the UDSRs.

Table 12-19. Bit Settings for UDSR—Offsets 0x510, 0x610

Bit	Name	Reset Value	R/W	Description
7–2	—	All 0s	R	Reserved

Table 12-19. Bit Settings for UDSR—Offsets 0x510, 0x610 (continued)

<table>
<tr><th>Bit</th><th>Name</th><th>Reset Value</th><th>R/W</th><th>Description</th></tr>
<tr><td>1</td><td>TXRDY</td><td>0</td><td>R</td><td>Transmitter ready reflects the status of the transmitter FIFO or the UTHR. The status is dependent on the DMA mode selected, which is determined by the DMS and FEN bits in the UFCR.
0 This bit is cleared in the following instances:
<table>
<tr><th>DMS</th><th>FEN</th><th>Mode</th><th>Meaning</th></tr>
<tr><td>0</td><td>0</td><td>0</td><td>TXRDY is cleared when there are no characters in the transmitter FIFO or UTHR.</td></tr>
<tr><td>0</td><td>1</td><td>0</td><td>TXRDY is cleared when there are no characters in the transmitter FIFO or UTHR</td></tr>
<tr><td>1</td><td>0</td><td>0</td><td>TXRDY is cleared when there are no characters in the transmitter FIFO or UTHR.</td></tr>
<tr><td>1</td><td>1</td><td>1</td><td>TXRDY is cleared when there are no characters in the transmitter FIFO or UTHR. TXRDY remains clear when the transmitter FIFO is not yet full.</td></tr>
</table>
1 This bit is set in the following instances:.
<table>
<tr><th>DMS</th><th>FEN</th><th>Mode</th><th>Meaning</th></tr>
<tr><td>0</td><td>0</td><td>0</td><td>TXRDY is set after the first character is loaded into the transmitter FIFO or UTHR.</td></tr>
<tr><td>0</td><td>1</td><td>0</td><td>TXRDY is set after the first character is loaded into the transmitter FIFO or UTHR.</td></tr>
<tr><td>1</td><td>0</td><td>0</td><td>TXRDY is set after the first character is loaded into the transmitter FIFO or UTHR.</td></tr>
<tr><td>1</td><td>1</td><td>1</td><td>TXRDY is set when the transmitter FIFO is full.</td></tr>
</table></td></tr>
</table>

Table 12-19. Bit Settings for UDSR—Offsets 0x510, 0x610 (continued)

<table>
<tr><th>Bit</th><th>Name</th><th>Reset Value</th><th>R/W</th><th>Description</th></tr>
<tr><td>0</td><td>RXRDY</td><td>1</td><td>R</td><td>Receiver ready reflects the status of the receiver FIFO or URBR. The status is dependent on the DMA mode selected, which is determined by the DMS and FEN bits in the UFCR.
0 This bit is cleared in the following instances:
<table>
<tr><th>DMS</th><th>FEN</th><th>Mode</th><th>Meaning</th></tr>
<tr><td>0</td><td>0</td><td>0</td><td>RXRDY is cleared when there is at least one character in the receiver FIFO or URBR.</td></tr>
<tr><td>0</td><td>1</td><td>0</td><td>RXRDY is cleared when there is at least one character in the receiver FIFO or URBR.</td></tr>
<tr><td>1</td><td>0</td><td>0</td><td>RXRDY is cleared when there is at least one character in the receiver FIFO or URBR.</td></tr>
<tr><td>1</td><td>1</td><td>1</td><td>RXRDY is cleared when the trigger level or a time-out has been reached and remains cleared until the receiver FIFO is empty.</td></tr>
</table>
1 This bit is set in the following instances:.
<table>
<tr><th>DMS</th><th>FEN</th><th>Mode</th><th>Meaning</th></tr>
<tr><td>0</td><td>0</td><td>0</td><td>RXRDY is set when there are no characters in the receiver FIFO or URBR.</td></tr>
<tr><td>0</td><td>1</td><td>0</td><td>RXRDY is set when there are no characters in the receiver FIFO or URBR.</td></tr>
<tr><td>1</td><td>0</td><td>0</td><td>RXRDY is set when there are no characters in the receiver FIFO or URBR.</td></tr>
<tr><td>1</td><td>1</td><td>1</td><td>RXRDY is set when the trigger level has not been reached and there has been no time out.</td></tr>
</table></td></tr>
</table>

12.4.14DUART Configuration Register (DCR)

The DCR allows the DUART to be set into a single UART or a special 4-pin DUART mode. The interrupt can be routed from each UART to either the processor core, through the PIC unit, or to the PCI bus.

DCR1 and DCR2 are actually treated as one register; a write to DCR1 also writes DCR2 and vice versa.

Figure 12-17 shows the bits in the DCRs.

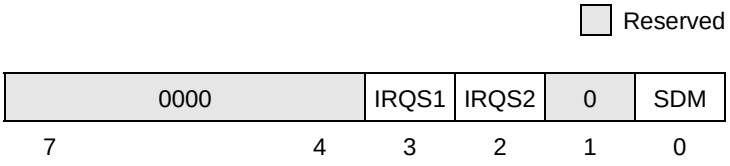


Figure 12-17. DUART Configuration Register (DCR)

Table 12-20 describes the bit settings for the DCRs.

Table 12-20. Bit Settings for DCR—Offsets 0x511, 0x611

Bit	Name	Reset Value	R/W	Description
7–4	—	All 0s	R	Reserved
3	IRQS1	0	R/W	IRQS1 (UART1) 0 UART interrupt is passed to the processor core through the PIC unit. 1 UART interrupt is routed to PCI bus.
2	IRQS2	0	R/W	IRQS2 (UART2) 0 UART interrupt is passed to the processor core through the PIC unit. 1 UART interrupt is routed to PCI bus.
1	—	0	R	Reserved
0	SDM	0	R/W	Special 4-pin DUART Mode. The multiplexed SOUT2/$\overline{\text{RTS1}}$ and SIN2/$\overline{\text{CTS1}}$ signals are used as follows: 0 Default 4-signal UART mode. UART1 is used. The following signals are used: SOUT1, $\overline{\text{CTS1}}$, SIN1, $\overline{\text{RTS1}}$. 1 Special 4-signal DUART mode. The following signals are used: SOUT1, SIN1, SOUT2, and SIN2. Both UART1 and UART2 are active.

Chapter 13
Central Control Unit

The MPC8245 uses internal buffering to store addresses and data moving through it, and to maximize opportunities for concurrent operations. A central control unit directs the flow of transactions through the MPC8245, performing internal arbitration and coordinating the internal and external snooping. This chapter describes the internal buffering and arbitration logic of the MPC8245 central control unit (CCU). See Chapter 5, “G2 Processor Core,” for more detailed information about the kinds of internal transactions that the processor snoops.

NOTE

Buffers that this chapter describes do not include the internal data bus buffers in the memory interface unit that improve electrical performance (speed and loading). For more information see Chapter 6, “Memory Interface.” Note also that in this chapter, ‘local memory’ denotes memory that the MPC8245 controls.

13.1 Internal Buffers

For most MPC8245 operations, data is latched internally in one of eight data buffers. Each of the eight internal data buffers has a corresponding address buffer. An additional buffer stores the address of the most recent (or current) processor access to local memory. All transactions that enter the MPC8245 have their addresses stored in the internal address buffers. The address buffers allow the addresses to be snooped as other transactions attempt to go through the MPC8245. This allowance is especially important for write transactions that enter the MPC8245 because memory can be updated out-of-order with respect to other transactions.

The CCU directs the bus snooping (if snooping is enabled) for each PCI access to local memory to enforce coherency between the PCI-initiated access and the data caches. All addresses are snooped in the order that they are received from the PCI bus. For systems that do not require hardware-enforced coherency, snooping can be disabled by setting the CF_NO_SNOOP parameter in PICR2. If snooping is disabled, the PCI exclusive access mechanism (the $\overline{\text{LOCK}}$ signal) does not affect the transaction. The transaction completes but the processor is not prohibited from accessing the cache line.

The MPC8245 supports critical word-first burst transactions (double word aligned) from the processor core. The CCU transfers this double word of data first, followed by double words from increasing addresses wrapping back to the beginning of the eight-word block, as required.

Figure 13-1 shows the organization of the internal buffers.

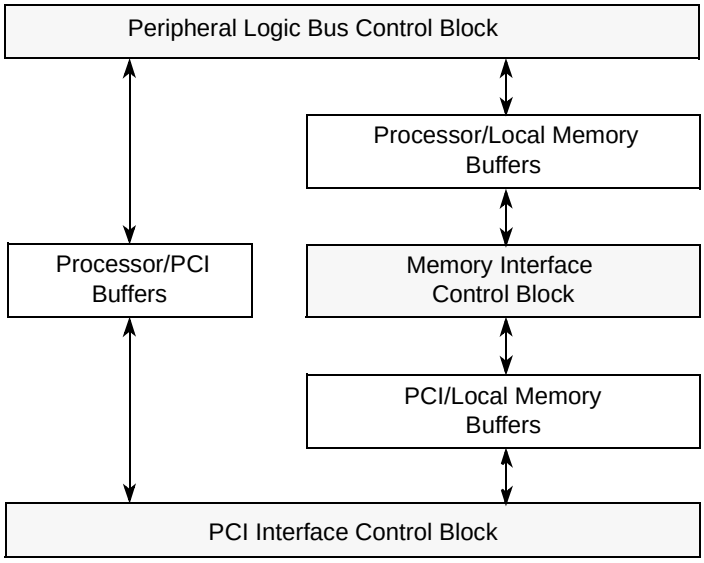


Figure 13-1. MPC8245 Internal Buffer Organization

13.1.1 Processor Core/Local Memory Buffers

Because the MPC8245 has a shared internal data bus between the processor and local memory, usually buffering data transfers between these devices is not necessary. However, a 32-byte copyback buffer is used for temporary storage of the following:

- Cache copyback data from snooping PCI-initiated reads from memory
- Sub-double word, single-beat writes when read-modify-write (RMW) parity is used
- Processor burst writes when ECC is enabled

The copyback buffer can be in only one of two states, invalid or modified with respect to local memory. Because the buffer is used for burst write data only, the entire cache line in the buffer is always valid if any part of the cache line is valid.

Figure 13-2 shows the address and data buffers between the peripheral logic bus and the local memory bus.

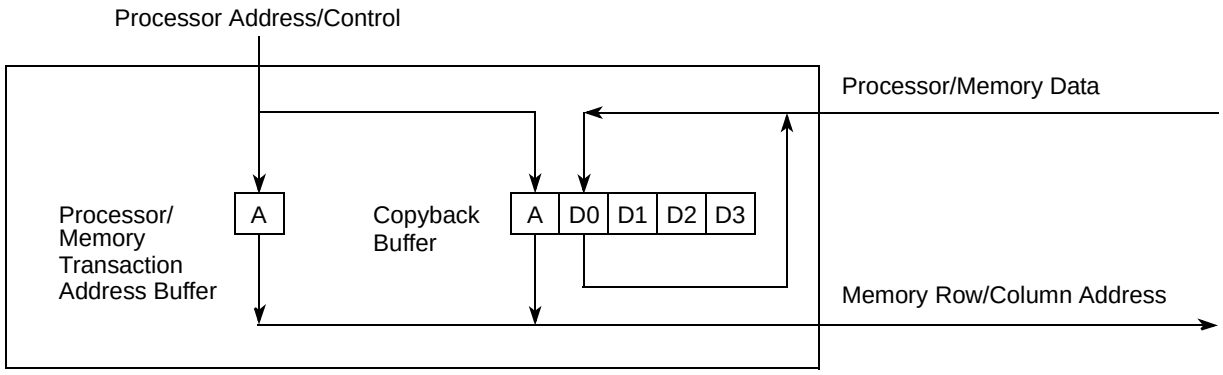


Figure 13-2. Processor/Local Memory Buffers

For a snoop for a PCI read from local memory that causes an cache copyback, the copyback data is simultaneously latched in the copyback buffer and the PCI-read-from-local-memory buffer (PCMRB). When the cache copyback is complete, the data is forwarded to the PCI agent from the PCMRB. The MPC8245 flushes the data in the copyback buffer to local memory at the earliest available opportunity.

For processor burst writes to memory with ECC enabled, the MPC8245 uses the copyback buffer as a temporary holding area while it generates the appropriate ECC codes to send to memory.

After the copyback buffer is filled, the data remains in the buffer until the local memory bus is available to flush the copyback buffer contents to local memory. During the time that modified data waits in the copyback buffer, all transactions to local memory space are snooped against the copyback buffer. All PCI-initiated transactions that hit in the copyback buffer cause the copyback buffer to have the highest priority for being flushed out to main memory.

13.1.2 Processor/PCI Buffers

The three data buffers for processor accesses to PCI are the following: one 32-byte processor-to-PCI-read buffer (PRPRB) for processor reads from PCI and two 16-byte processor-to-PCI-write data buffers (PRPWBs) for processor writes to PCI.

Figure 13-3 shows the address and data buffers between the peripheral logic bus and the PCI bus.

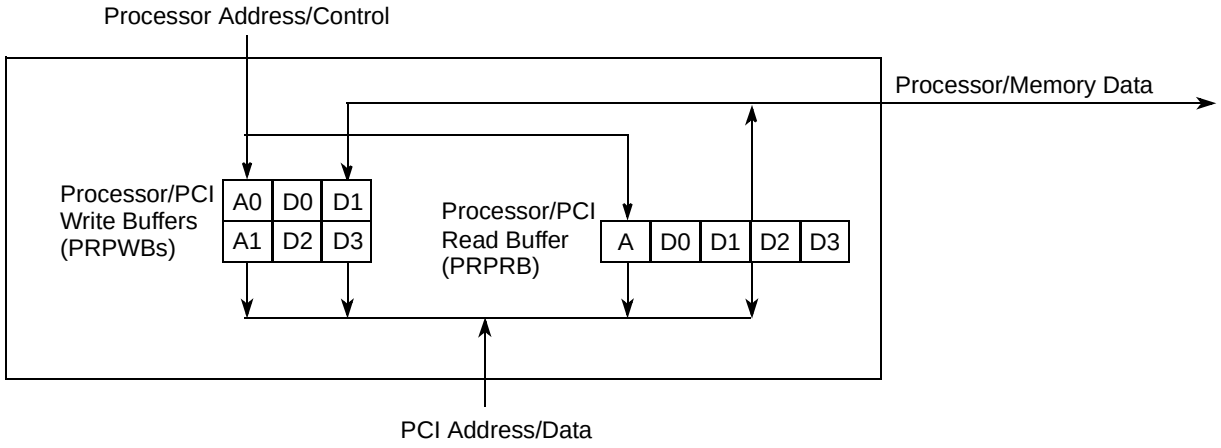


Figure 13-3. Processor/PCI Buffers

13.1.2.1 Processor-to-PCI-Read Buffer (PRPRB)

Processor reads from PCI require buffering for the following two primary reasons:

- The processor bus uses a critical-word-first protocol, while the PCI bus uses a zero-word-first protocol. The MPC8245 requests the data zero-word-first, latches the requested data, and delivers the data to the processor core as critical-word-first.
- The MPC8245 may have to handle a local memory access from an alternate PCI master before the disconnected transfer can continue if the target for a processor read from PCI disconnects during the data transfer.

When the processor requests data from PCI space, the data received from PCI is stored in the PRPRB until all requested data is latched. The CCU does not terminate the address tenure of the internal transaction until all requested data is latched in the PRPRB. If the PCI target disconnects in the middle of the data transfer and an alternate PCI master acquires the bus and initiates a local memory access, the CCU retries the ongoing internal transaction with the processor core so that the incoming PCI transaction can be snooped. A PCI-initiated access to local memory may require a snoop transaction on the internal peripheral logic bus and also a copyback. The CCU does not provide the data to the peripheral logic bus (for the processor-to-PCI read transaction) until all outstanding snoops for PCI writes to local memory are complete.

If a processor read from a PCI transaction is waiting for a PCMWB snoop to complete (that is, data has been latched into PRPRB from the PCI bus but has not yet returned to the processor and perhaps the processor must retry the read), all subsequent requests for PCI writes to local memory are retried on the PCI bus.

The PCI interface of the MPC8245 continues to request mastership of the PCI bus until the processor’s original request is completed. When the next processor transaction starts, the

address is snooped against the address of the previous transaction (in the internal address buffer) to verify that the same cache line is being requested. When all the requested data is latched and all PCI-write-to-local memory snoops complete, the CCU completes the data transfer to the processor.

For example, if the processor initiates a critical-word-first burst read, starting with the second double word of a cache line, the read on the PCI bus begins with the cache-line-aligned address. If the PCI target disconnects after transferring the first half of the cache line, the MPC8245 re-arbitrates for the PCI bus, and when granted, initiates a new transaction with the address of the third double word of the line. If an alternate PCI master requests data from local memory while the MPC8245 is waiting for the PCI bus grant, the central control unit internally retries the processor core transaction to allow the PCI-initiated transaction to be snooped by the processor core. When the processor snoop is complete, the subsequent processor transaction is compared to the latched address and attributes of the PRPRB to ensure that the processor is requesting data for the same cache line. After all data that the processor requested is latched in the PRPRB, the data is transferred to the processor, completing the transaction.

13.1.2.2 Processor-to-PCI-Write Buffers (PRPWBs)

The two 16-byte buffers for processor writes to PCI can be used together as one 32-byte buffer for processor burst writes to PCI, or separately for single-beat writes to PCI. This arrangement allows the MPC8245 to support both burst transactions and streams of single-beat transactions. The MPC8245 performs store gathering (if enabled) of sequential accesses within the 16-byte range that comprises either the first or second half of the cache line. All transfer sizes are gathered if enabled (PICR1[ST_GATH_EN] = 1).

Internal buffering minimizes the effect of the slower PCI bus on the higher-speed peripheral logic bus that interfaces to the processor core. After the processor write data is latched internally, the peripheral logic bus is available for subsequent transactions and does not need to wait for the write to the PCI target to complete.

NOTE

Both PCI memory and I/O accesses are buffered. Device drivers must take into account that writes to I/O devices on the PCI bus are posted. The processor may believe that the write completed while the MPC8245 is still trying to acquire mastership of the PCI bus.

If the processor core initiates a burst write to PCI, the processor data transfer is delayed until all previous writes to PCI are completed, and the burst data from the processor fills the two PRPWBs. The address and transfer attributes are stored in the first address buffer.

For a stream of single-beat writes, the data for the first transaction is latched in the first buffer and the MPC8245 initiates the transaction on the PCI bus. The second single-beat

write is then stored in the second buffer. For subsequent single-beat writes, store gathering is possible if the incoming write is to sequential bytes in the same half-cache line as the previously latched data. Store gathering is used only for writes to PCI memory space, rather than for writes to PCI I/O space. The store gathering continues until the buffer is scheduled to be flushed or until the processor issues a synchronizing transaction.

For example, if both PRPWBs are empty and the processor issues a single-beat write to PCI, the data is latched in the first buffer and the PCI interface of the MPC8245 requests mastership of the PCI bus for the transfer. The data for the next processor-to-PCI write transaction is latched in the second buffer, even if the second transaction's address falls within the same half-cache line as the first transaction. While the PCI interface is busy with the first transfer, any sequential processor single-beat writes within the same half-cache line as the second transfer is gathered in the second buffer until the PCI bus becomes available.

13.1.3 PCI/Local Memory Buffers

The eight data buffers for PCI accesses to local memory—up to four 32-byte PCI-to-local memory read buffers (PCMRBs) for PCI reads from local memory and up to four 32-byte PCI-to-local memory write buffers (PCMWBs) for PCI writes to local memory. Figure 13-4 shows the address and data buffers between the PCI bus and the local memory.

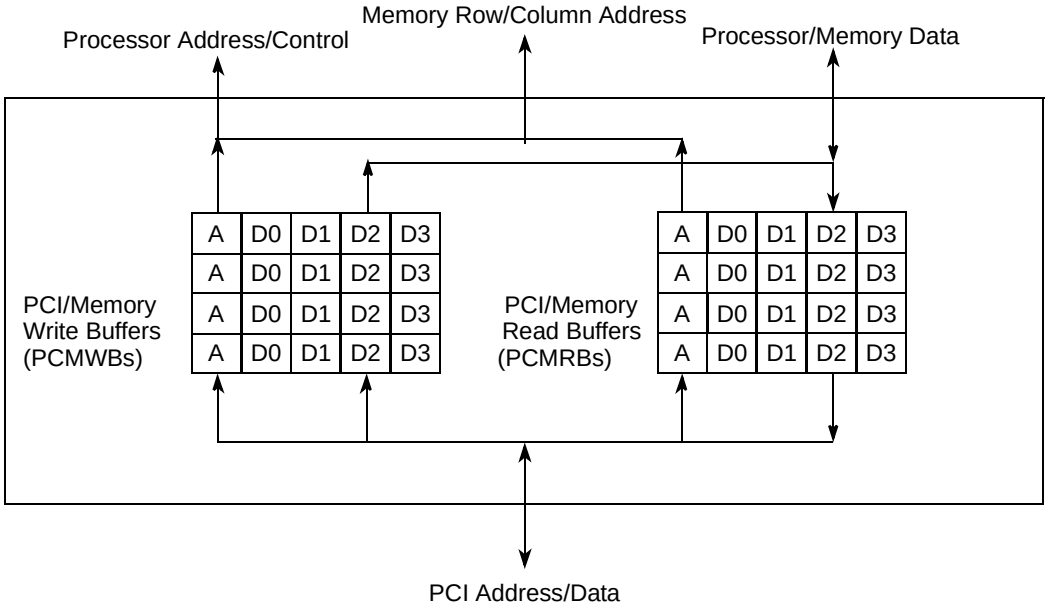


Figure 13-4. PCI/Local Memory Buffers

The number of buffers available is determined by PCI/Memory buffer configuration register. See Section 4.11, "PCI/Memory Buffer Configuration Register—0xE1," for more information.

Many PCI accesses to local memory are snooped on the peripheral logic bus to ensure coherency between the PCI bus, local memory, and the cache of the processor. All snoops for PCI accesses to local memory are performed strictly in order.

Table 13-1 summarizes the snooping behavior of PCI accesses to local memory that hit in one of the internal buffers.

Table 13-1. Snooping Behavior Caused by a Hit in an Internal Buffer

PCI Transaction	Hit in Internal Buffer	Snoop Required
Read	Copyback	Yes
Read (not locked)	PCMRB	No
Read (first access of a locked transfer) [1]	PCMRB	Yes
Read (not locked)	PCMWB	No
Read (first access of a locked transfer)[1]	PCMWB	Yes
Write	Copyback	Yes
Write	PCMRB	Yes
Write	PCMWB	No

[1] Only reads can start an exclusive access (locked transfer). The first locked transfer must be snooped so that the cache line is invalidated.

13.1.3.1 PCI-to-Local-Memory Read Buffering

The following sections describe the PCMRB buffer and the capability of the MPC8245 to perform speculative PCI reads from local memory.

13.1.3.1.1 PCI-to-Local-Memory Read Buffers (PCMRBs)

When a PCI device initiates a read from local memory, the address is snooped on the peripheral logic bus (if snooping is enabled). If the memory interface is available, the memory access is started simultaneously with the snoop. If the snoop results in a hit in the cache, the MPC8245 cancels the local memory access.

Depending on the outcome of the snoop, the requested data is latched into one of the 32-byte PCMRBs or into both the copyback buffer and a PCMRB (see Section 13.1.1, “Processor Core/Local Memory Buffers”) as follows:

- If the snoop hits in the cache, the copyback data is written to the copyback buffer and copied to the PCMRB when the copyback buffer is flushed to memory. The data is forwarded to the PCI bus from the PCMRB, and to local memory from the copyback buffer.
- If the snoop does not hit in the cache, a PCMRB is filled from local memory with the entire corresponding cache line, regardless of whether the starting address of the

PCI-initiated transaction was at a cache-line boundary. The data is forwarded to the PCI bus from the PCMRB as the PCMRB is loaded, and the CCU doesn't wait for the PCMRB to be full.

The data is forwarded to the PCI bus as soon as it is received, instead of when the complete cache line is written into a PCMRB. The addresses for subsequent PCI reads are compared to the existing address so that if the new access falls within the same cache line and the requested data is already latched in the buffer, the data can be forwarded to PCI without requiring a snoop or another memory transaction.

If a PCI write to local memory hits in a PCMRB, the PCMRB is invalidated and the address is snooped on the peripheral logic bus. If the processor core accesses the address in the PCMRB, the PCMRB is invalidated.

13.1.3.1.2 Speculative PCI Reads from Local Memory

To minimize the latency for large block transfers, the MPC8245 provides the ability to perform speculative PCI reads from local memory. When speculative reading is enabled (or a PCI read multiple transfer requests data word 2 of a cache line), the MPC8245 starts the snoop of the next sequential cache-line address. After the speculative snoop response is known and the MPC8245 completes the current PCI read, the data at the speculative address is fetched from local memory and loaded into an other PCMRB to anticipate the next PCI request.

Using the PCI memory-read-multiple command enables speculative PCI reads on a per access basis. Setting bit 2 in PICR1 can enable speculative PCI reads for all PCI memory read commands (memory-read, memory-read-multiple, and memory-read-line).

The MPC8245 starts the speculative read operation under the following conditions only:

- PICR1[2] = 1 or the current PCI read access is from a memory-read-multiple command.
- No internal buffer flushes are pending.
- The address does not cross a 4-Kbyte boundary.
- The access is not a locked transaction.
- No outstanding configuration register accesses from the processor occur.
- Access is to local SDRAM space. The MPC8245 does not perform speculative reads from local ROM space.

13.1.3.2 PCI-to-Local-Memory-Write Buffers (PCMWBs)

For PCI-write transactions to local memory, the MPC8245 employs up to four PCMWBs. The PCMWBs hold up to one cache line (32 bytes) each. Before PCI data is transferred to local memory, the address must be snooped on the peripheral logic bus (if snooping is enabled). The buffers allow for the data to be latched while waiting for a snoop response.

The write data can be accepted without inserting wait states on the PCI bus. Also, four buffers allow a PCI master to write to one buffer while an other buffer is flushing its contents to local memory. The PCMWBs are capable of gathering for writes to the same cache line.

If the snoop on the peripheral logic bus hits modified data in the cache, the snoop copyback data is merged with the data in the appropriate PCMWB and the full cache line is sent to memory. For the PCI memory-write-and-invalidate command, a snoop hit in the cache invalidates any modified cache line without requiring a copyback.

NOTE

A PCI transaction that hits in a PCMWB does not require a snoop on the peripheral logic bus. However, if a PCI write address hits in a PCI-read-from-local-memory buffer (PCMRB), the CCU invalidates the PCMRB and snoops the address on the peripheral logic bus.

When the PCI write is complete and the snooping is resolved, the data is flushed to memory at the first available opportunity.

For a stream of single-beat writes, the data for the first transaction is latched in the first buffer and the CCU initiates the snoop transaction on the peripheral logic bus. For subsequent single-beat writes, gathering is possible if the incoming write is to the same cache line as the previously latched data. Gathering in the first buffer can continue until the buffer is scheduled to be flushed or until a write occurs to a different address. If valid data is in all available buffers, further gathering is not supported until one of the buffers is flushed.

13.2 Internal Arbitration

The MPC8245 performs arbitration internally for the internal shared processor/memory data bus. All processor-to-PCI transactions are performed strictly in order with respect to the MPC8245. Also, all snoops for PCI accesses to local memory are performed in order (if snooping is enabled).

13.2.1 Arbitration Between PCI and DMA Accesses to Local Memory

For the purposes of the CCU, the two DMA channels of the MPC8245 DMA controller function as PCI devices on the MPC8245, as shown in Figure 13-5.

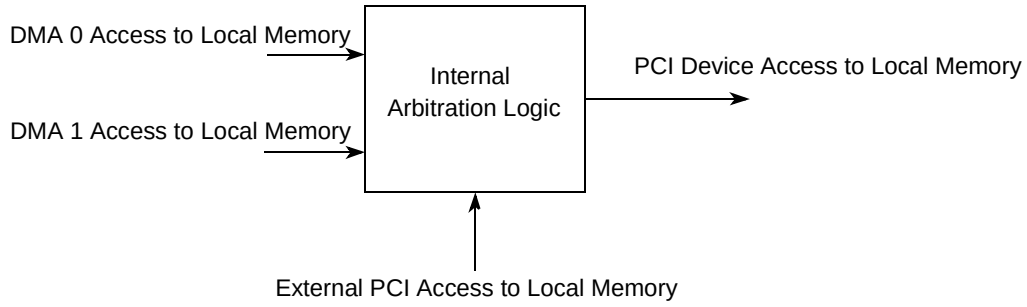


Figure 13-5. PCI/DMA Arbitration for Local Memory Accesses

The priority between simultaneous accesses from the external PCI bus and the DMA controller to the shared processor/memory data bus is controlled by the arbiter shown in Figure 13-5 as follows:

- External PCI masters always have greater priority than DMA accesses.
- The priority between DMA channels 0 and 1 is round-robin.

If a DMA channel is currently accessing local memory, accesses from external PCI devices are retried. Rearbitration within this arbiter between the DMA channels and external PCI masters occurs at DMA transaction boundaries. Setting of the DMR[LMDC] value affects DMA transaction boundaries for some DMA-initiated transactions (see the following sections and Section 8.7.1, “DMA Mode Registers (DMRs),” for detailed information about DMR[LMDC]).

13.2.1.1 DMA Transaction Boundaries for Memory/Memory Transfers

DMA transaction boundaries for local memory to local memory transfers occur as follows:

- When DMR[LMDC] is 0b00
  - — After each cache-line write for DMA writes to local memory
  - — After up to two cache-line reads for DMA reads from local memory
- When DMR[LMDC] is nonzero, DMA transaction boundaries occur after the transfer of a single cache line for both reads and writes to local memory.

Depending on the timing of an incoming PCI transfer, if a DMA channel is performing local memory to local memory transfers, the external PCI master may be repeatedly retried. Besides affecting the DMA transaction boundaries, the value of the DMR[LMDC] also increases the time delay between subsequent DMA accesses to local memory. To reduce the occurrence of PCI retries in this case, software can increase the value of the DMR[LMDC] value to cause more latency in between DMA accesses to local memory, giving a greater probability that the PCI can gain access to the processor/memory data bus.

13.2.1.2 DMA Transaction Boundaries for Memory-to-PCI Transfers

DMA transaction boundaries for local memory-to-PCI transfers occur as follows:

- When DMR[LMDC] is 0b00, DMA transaction boundaries occur after the streaming (reads) of up to 4 Kbytes from local memory.
- When DMR[LMDC] is nonzero, DMA transaction boundaries occur after the transfer of a single cache line for reads from local memory.

For a DMA channel to stream (up to 4 Kbytes) from local memory to the PCI bus, the PCI bus must be available to sustain the streaming. The latency timer parameter in the PCI latency timer register (PLTR) can affect the streaming of data to the PCI bus. If the latency timer is set to be a shorter period than the time required to transfer 4 Kbytes, the PCI stream terminates when another PCI master is granted mastership of the PCI bus. The latency timer parameter in the PLTR is described further in Section 4.2.6, “Latency Timer—Offset 0x0D.”

As described for memory to memory transfers, nonzero values of the DMR[LMDC] also increase the time delay between subsequent DMA accesses to local memory for memory-to-PCI transfers.

13.2.1.3 DMA Transaction Boundaries for PCI—Memory Transfers

The DMA transaction boundaries for DMA writes to local memory from the PCI bus occur after the transfer of a single cache line for all values of DMR[LMDC]. Nonzero values of the DMR[LMDC] increase the time delay between subsequent DMA accesses to local memory for PCI to local memory transfers.

13.2.1.4 PCI and DMA Reads from Slow Memory/Port X

As Section 7.4.3.2, “Target-Initiated Termination” describes, if the MPC8245 cannot read the first data beat of a burst from local memory within 16 PCI clock cycles, the transaction has timed out internally. As a target, the MPC8245 terminates the transaction with a retry. In this case, the CCU continues the access to memory (as a speculative PCI read) to anticipate the PCI device request for the same transaction at a later time. When the PCI device attempts the read again, the transaction is rearbitrated with DMA transactions within the PCI interface as a new transaction (not speculative). If the data was successfully read into the PCMRB from memory, the CCU provides the data to the PCI bus.

Similarly, the DMA controller attempts to complete a read from local memory in 32 PCI clock cycles. If the read does not complete within that time, the CCU continues the access to memory (as a speculative PCI read in Table 13-2) on behalf of the DMA channel, but the DMA transaction is considered to have timed out within the PCI interface. After allowing for rearbitration within the PCI interface unit of the MPC8245, the DMA channel attempts the read again (an action that is not considered speculative). If the MPC8245 completed the read, the CCU provides the data to the DMA unit.

13.2.2 Internal Arbitration Priorities

The overall arbitration for the processor/memory data bus employs the priority scheme shown in Table 13-2. Note that the DMA channels function as PCI devices with respect to the processor/memory data bus, the entries for PCI reads and writes in the table also implicitly include the cases for DMA reads and writes, and they are arbitrated as Section 13.2.1, “Arbitration Between PCI and DMA Accesses to Local Memory” describes.

The arbitration boundaries for access to the processor/memory data bus shown in Table 13-2 occur on a cache-line basis. After every cache line is transferred, requests for access to the processor/memory bus are ranked by the priorities shown in the table.

Note that the first access of a multi-cache-line read (generated by a PCI master or the DMA unit) is classified as a PCI read in the table. If snooping is enabled, subsequent reads in multi-cache-line accesses are classified as speculative PCI reads in the table (with a priority of 10) until the snoop completes. Then access changes to a priority of 2. If snooping is disabled, the subsequent reads in multi-cache-line accesses are classified as speculative PCI reads with a priority of 2.

Table 13-2. Internal Arbitration Priorities

Priority	Operation
1	High-priority copyback buffer flush caused by one of the following: • A PCI access to local memory hits in the copyback buffer. • A processor burst write to local memory with ECC enabled hits an address in the PCMWB (with snoop not complete). • A processor burst write to local memory with ECC enabled hits an address in the PCMRB (with snoop not complete).
1.5	Pipelined processor reads or writes to local memory (occurring only when snooping is disabled)
2	PCI read or speculative PCI read from local memory with snoop complete (or snooping disabled). See Section 13.2.3, “Guaranteeing Minimum PCI Access Latency to Local Memory.”
3	Processor read from local memory
4	High priority PCMWB flush due to one of the following: • A PCI read hits in the PCMWB. • The PCMWB is full and another PCI write to local memory starts. • A processor to local memory read hits in the PCMWB. • A processor to local memory single-beat write hits in the PCMWB.
5	Medium priority copyback buffer flush due to one of the following: • A processor read hits in the copyback buffer. • A processor single-beat write hits in the copyback buffer. • The copyback buffer is full and new data needs to be written to it.
6	Normal processor transfers including the following: • A processor write to local memory • A snoop copyback due to a PCI write snoop • A processor read from PCI • A processor write to PCI • A copyback buffer fill

Table 13-2. Internal Arbitration Priorities (continued)

Priority	Operation
7	A PCI read from local memory with snoop not complete. See Section 13.2.3, “Guaranteeing Minimum PCI Access Latency to Local Memory.”
8	Low-priority copyback buffer flush
9	Low-priority PCMWB flush
10	PCMRB prefetch from local memory due to a speculative PCI read operation

13.2.3 Guaranteeing Minimum PCI Access Latency to Local Memory

On the MPC8245, clearing PICR2[NOSNOOP_EN] to enable snooping can improve the PCI access latency to local memory by eliminating pipelined processor transactions that have a priority 1.5 in Table 13-2. However, overall system performance may be degraded if all transactions are snooped on the internal processor bus.

Chapter 14
Error Handling

The MPC8245 provides error detection and reporting on the three following primary interfaces:

- Processor core
- Memory
- PCI

This chapter describes how the MPC8245 handles different error conditions. Interrupts that are routed to the programmable interrupt controller (PIC) are detected and the PIC reports them, but these interrupts are not part of the internal error handling of the MPC8245 described in this chapter. See Chapter 11, “Programmable Interrupt Controller (PIC) Unit,” for more information about the PIC unit.

14.1 Overview

Errors that the MPC8245 detects are reported to the processor core by asserting an internal machine check signal ($\overline{mcp}$). The state of the internal machine check signal is externally driven on the $\overline{\text{MCP}}$ output signal. The system error ($\overline{\text{SERR}}$) and parity error ($\overline{\text{PERR}}$) signals report errors on and to the PCI bus. The MPC8245 provides the NMI signal for ISA bridges to report errors on the ISA bus and internally synchronizes any asynchronous error signals.

The PCI command, PCI status, and error handling registers enable or disable the reporting and detection of specific errors. These registers are described in Chapter 4, “Configuration Registers.”

The MPC8245 detects illegal transfer types from the following origins:

- Processor
- Illegal Flash write transactions
- PCI address
- Data parity errors
- Accesses to memory
- Addresses out of the range of physical memory
- Memory parity errors

- Memory refresh overflow errors
- ECC errors
- PCI master-abort cycles
- PCI received target-abort errors

The MPC8245 latches the address and type of transaction that caused the error in the error status registers to assist diagnostic and error handling software. Note that not all transactions can be captured.

See Section 4.8.2, “Error Enabling and Detection Registers,” for more information. Section 2.2.6, “System Control and Power Management Signals,” contains signal definitions for the interrupt signals.

14.1.1 Error Handling Block Diagram

Figure 14-1 shows the internal error management block diagram.

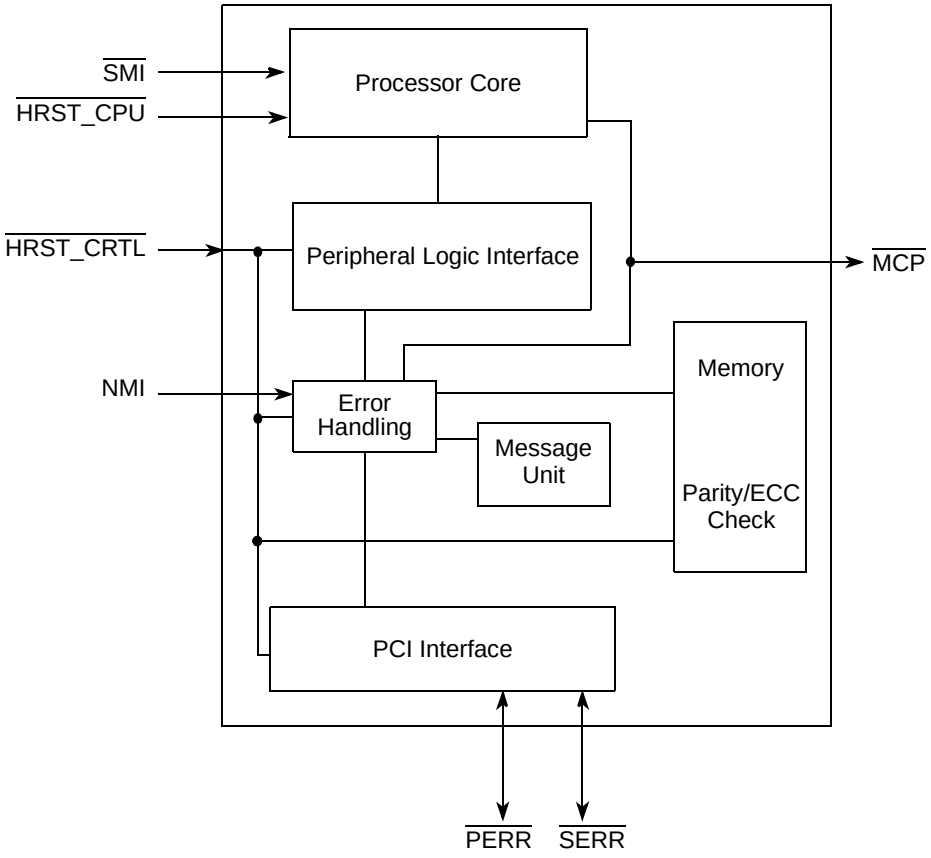


Figure 14-1. Internal Error Management Block Diagram

14.1.2 Priority of Externally Generated Errors and Exceptions

Many of the errors that are detected in the MPC8245 cause the processor core to take exceptions. Table 14-1 describes the relative error priorities. The processor exception that each of these conditions generates is described in Section 5.5, “Exception Model.”

Table 14-1. MPC8245 Error Priorities

Priority	Exception	Cause
0	Hard reset	Hard reset (required on power-on), $\overline{\text{HRST_CRTL}}$ and $\overline{\text{HRST_CPU}}$ asserted (must always be asserted together).
1	Machine check	Processor transaction error or Flash write error
2	Machine check	PCI address parity error ($\overline{\text{SERR}}$) or PCI data parity error ($\overline{\text{PERR}}$) when MPC8245 is acting as the PCI target
3	Machine check	Memory select error, processor write parity error, memory data read parity error, memory refresh overflow, or ECC error.
4	Machine check	PCI address parity error ($\overline{\text{SERR}}$) or PCI data parity error ($\overline{\text{PERR}}$) when MPC8245 is acting as PCI master, PCI master-abort, or received PCI target-abort.
5	Machine check	NMI (nonmaskable interrupt), inbound doorbell register machine check (IDBR[MC]), or inbound message register overflow flags (IMISR[OFO] and IMISR[IPO])

For priorities 1 through 5, the exception is the same. The machine check exception and the priority are related to additional error information that the MPC8245 provides (for example, the address provided in the Processor/PCI error address register).

14.2 Exceptions and Error Signals

Although Section 2.2.6, “System Control and Power Management Signals,” contains the signal definitions for the exception and error signals, this section describes the interactions between system components when an exception or error signal is asserted.

14.2.1 System Reset

The system reset exception is an asynchronous, nonmaskable interrupt that occurs when the hard reset input signals ($\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$) are both asserted (required at power-on). The MPC8245 has two hard reset input signals, $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CRTL}}$, that must be asserted and negated simultaneously.

When a system reset is recognized ($\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$ are both asserted), the MPC8245 does the following:

- Ends all current internal and external transactions
- Releases all bidirectional I/O signals to a high-impedance state
- Ignores the input signals (except for PCI_SYNC_IN and the configuration signals described in Section 2.4, “Configuration Signals Sampled at Reset”)
- Drives most of the output signals to an inactive state.

Table 2-2 in Section 2.1, “Signal Overview” shows the states of the output-only signals during system reset. The MPC8245 then initializes its internal logic.

For proper initialization, the assertion of $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$ must satisfy the minimum active pulse width requirements that the *MPC8245 Integrated Processor Hardware Specifications* lists.

NOTE

Latches that are dedicated to JTAG functions are not initialized during system reset. The IEEE 1149.1 standard prohibits the device reset from resetting the JTAG logic. The JTAG reset ($\overline{\text{TRST}}$) signal is required to reset the dedicated JTAG logic during power-on.

14.2.2 Processor Core Error Signal ($\overline{mcp}$)

The MPC8245 provides an internal machine check signal ($\overline{mcp}$) to the processor core for error reporting.

The internal machine check signal indicates to the processor that a nonrecoverable error occurred during system operation. The state of $\overline{mcp}$ is provided externally on the $\overline{\text{MCP}}$ output signal. Assertion of $\overline{mcp}$ depends upon whether the error handling registers of the MPC8245 are set to report the specific error. The programmable parameter PICR1[MCP_EN] can enable or disable the assertion of $\overline{mcp}$ by the MPC8245 for all error conditions. Assertion of $\overline{mcp}$ causes the processor core to take a machine check exception conditionally or enter the checkstop state based on the value of the processor’s MSR[ME] bit.

The machine check signal may be asserted to the processor core on any cycle. Whether the current transaction is aborted depends upon the software configuration.

The MPC8245 holds $\overline{mcp}$ asserted until the processor core takes the exception. The MPC8245 decodes a machine check acknowledge cycle by detecting processor reads from the two possible machine check exception addresses at 0x0000_0200–0x0000_0207 and 0xFFF0_0200–0xFFF0_0207, and negates $\overline{mcp}$.

NOTE

If the MPC8245 is configured for remote ROM (that is, ROM space is located in the PCI memory space), a processor read from 0xFFF0_0200 does not negate the *mcp* signal. In this case, the machine check exception handler must perform a dummy read from 0x0000_0200 to cause the negation of *mcp*.

14.2.3 PCI Bus Error Signals

The MPC8245 uses the following three error signals to interact with the PCI bus:

- SERR
- PERR
- NMI

14.2.3.1 System Error (SERR)

The SERR signal reports PCI system errors such as PCI address parity error, target-abort, or any other error where the result is potentially catastrophic. The SERR signal is also asserted for master-abort except for PCI configuration accesses or special-cycle transactions.

The agent that drives AD[31–0] on a given PCI bus phase is responsible for driving even parity one PCI clock cycle later on the PAR signal. That is, the number of ones on AD[31–0], C/BE[3–0], and PAR equals an even number.

The agent that is reporting the error drives the SERR signal for a single PCI clock cycle. The target agent cannot terminate with retry or disconnect if an address parity error has activated SERR.

Bit 8 of the PCI command register controls whether the MPC8245 asserts SERR when detecting any PCI system error. Whenever the MPC8245 asserts SERR to report a system error on the PCI bus, bit 14 of the PCI status register is set.

Bit 7 of ErrEnR1 enables the reporting (through *mcp*, if enabled) of SERR assertion by an external agent on the PCI bus. If ErrEnR1[7] = 1 with MPC8245 acting as the initiator, and an external PCI agent asserts SERR two clock cycles after the address phase, the error is recorded in bit 7 of ErrDR1 and a machine check is generated to the processor core.

14.2.3.2 Parity Error (PERR)

The PERR signal reports PCI data parity errors during all PCI transactions except for PCI special-cycle command transactions. The agent that is responsible for driving AD[31–0] on a given PCI bus phase is responsible for driving even parity one PCI clock cycle later on

the PAR signal. That is, the number of ones on AD[31–0], $\overline{\text{C/BE}}$[3–0], and PAR is an even number.

Two PCI clock cycles after the data phase for which a data parity error is detected, the agent receiving the data must assert the $\overline{\text{PERR}}$ signal. Only the master may report a read data parity error; and only the selected target may report a write data parity error.

Bit 6 of the PCI command register decides whether the MPC8245 ignores $\overline{\text{PERR}}$. Bit 15 and bit 8 of the PCI status register report when the MPC8245 detects or reports a data parity error.

14.2.3.3 Nonmaskable Interrupt (NMI)

The NMI signal is, effectively, a PCI sideband signal between the PCI-to-ISA bridge and the MPC8245. The PCI-to-ISA bridge usually drives the NMI signal to report any nonrecoverable error detected on the ISA bus (normally, through the $\overline{\text{IOCHCK}}$ signal on the ISA bus). Its history in ISA bus designs makes the name 'nonmaskable interrupt' misleading. The NMI signal should be connected to GND if it is not used. If PICR1[$\overline{\text{MCP}}$_EN] is set, the MPC8245 reports the NMI error to the processor core by asserting $\overline{mcp}$.

14.3 Error Reporting

Error detection on the MPC8245 logs the occurrence of an error and error condition information. The individual error detection bits are contained in the following registers:

- PCI status register, error detection register 1 (ErrDR1)
- Error detection register 2 (ErrDR2)I
- Inbound message interrupt status register (IMISR)

These bits indicate which error was detected. Error detection bits are bits 15, 13, and 12 in the PCI status register; bits 7–0 in ErrDR1, bits 7, 6, 3, 2, and 0 in ErrDR2, and bits 8, 7, and 4 in the IMISR.

The intent of error reporting is to log the information that pertains to the first error that occurs and prevent additional errors from being reported until the first error is acknowledged and cleared. To report additional errors, all error detection bits must be cleared. When an error detection bit is set, the MPC8245 does not report additional errors until all of the error detection bits are cleared. Because more than one of the error detection bits can be set if simultaneous errors are detected, software must check whether more than one bit is set before trying to determine information about the error.

The processor/PCI error address register, the processor bus error status register, and the PCI bus error status register together with ErrDR1[3] (processor/PCI cycle) and ErrDR2[7] (invalid error address) provide additional information about a detected error condition. When an error is detected, the associated information is latched inside these registers until

all error detection bits are cleared. Subsequent errors set the appropriate error detection bits, but the bus error status and error address registers retain the information for the initial error until all error detection bits are cleared.

As described in Section 14.2.2, "Processor Core Error Signal ($\overline{mcp}$)," the MPC8245 asserts $\overline{mcp}$ to the processor core when an enabled error condition occurs during system operation. The assertion of $\overline{mcp}$ depends on whether the error handling registers of the MPC8245 are set to report the specific error. When asserted, the MPC8245 continues to assert $\overline{mcp}$ until the MPC8245 decodes a read from the processor to the machine check exception vector (0xnnn0_0200). When it decodes a processor read from the machine check exception vector, the MPC8245 negates $\overline{mcp}$.

NOTE

If the system ROM space is located on the PCI bus, a processor read from 0xFFF0_0200 does not negate the $\overline{mcp}$ signal. In this case, the machine check exception handler must perform a dummy read from 0x0000_0200 to cause the negation of $\overline{mcp}$. Until all the error detection bits are cleared, the MPC8245 does not report subsequent errors by reasserting $\overline{mcp}$.

Certain events in the inbound portion of the message unit can cause the assertion of $\overline{mcp}$. These events can mask (or be masked by) other errors until the machine check exception handler clears them.

NOTE

Besides the error detection bits, the MPC8245 reports the assertion of NMI to the processor core by asserting $\overline{mcp}$ (if enabled). Note that NMI assertion is not recorded in the MPC8245 error detection bits. Reporting NMI assertion (by $\overline{mcp}$) can be masked by any error detection bits that are set.

14.3.1 Processor Interface Errors

The processor interface of the MPC8245 detects unsupported processor bus transaction errors, Flash write errors, and write parity errors. In these cases, both ErrDR1[3] and ErrDR2[7] are cleared, indicating that a processor transaction caused the error and the address in the processor/PCI error address register is valid. Internally, the MPC8245 asserts transfer acknowledge (provided PICR1[10] = 0) to terminate the data tenure.

14.3.1.1 Processor Transaction Error

When a processor transaction error occurs, ErrDR1[1–0] is set to reflect the error type. Unsupported processor bus transactions include writes to the PCI interrupt-acknowledge space (0xFEFn_nnnn) and attempts to execute the graphic read or graphic write instructions (**eciwx** or **ecowx**).

14.3.1.2 Flash Write Error

The MPC8245 allows processor writes to the local ROM space when PICR1[FLASH_WR_EN] is set and PICR2[FLASH_WR_LOCKOUT] is cleared. Otherwise, any processor write transaction to the local ROM space results in a Flash write error. Attempts to write to local ROM space from a PCI master or the DMA controller also cause Flash write errors. When a Flash write error occurs, ErrDR2[0] is set.

The ROM/Flash interface on the MPC8245 accommodates only single-beat, datapath-sized (8-, 32-, or 64-bit depending on the configuration) writes to Flash memory, requiring all writes to system ROM space to be either caching-inhibited or caching-allowed/write-through. Any burst write to ROM space causes a Flash write error.

Software must partition larger data into individual datapath-sized (8-, 32-, or 64-bit) write operations. Note that PICR1[NO_BUS_WIDTH_CHECK] controls whether the MPC8245 checks the data path size of processor writes to local base ROM space. If NO_BUS_WIDTH_CHECK is set, an attempt to write to Flash with a transfer size other than the base ROM data bus size (for example, a 32-bit write to 8-bit Flash) does not cause a Flash write error. If NO_BUS_WIDTH_CHECK is cleared, an attempt to write to Flash with a transfer size other than the base ROM data bus size causes a Flash write error.

14.3.1.3 Processor Write Parity Error

When both ErrEnR2[2] and MCCR2[INLINE_WR_EN] are set, the MPC8245 checks processor parity on memory write cycles with the stipulations that Table 14-2 describes.

Table 14-2. Processor Write Parity Checking

Memory Type	Memory Error Protocol [1]	Processor Write Parity Checking
SDRAM	None	Not supported
	Parity	Yes
	RMW parity	Not supported
	ECC	Yes

[1] SeeTable 6-9 for specific bit settings.

When a processor write parity error occurs, ErrDR2[2] is set. The MPC8245 does not check parity for write transactions to the PCI or the local ROM address space.

14.3.2 Memory Interface Errors

The memory interface of the MPC8245 detects read parity, ECC, memory select, and refresh overflow errors. The MPC8245 detects parity errors on the data bus during memory (SDRAM) read cycles. The memory controller can detect single- and multi-bit errors for local memory read transactions. Because the ECC logic corrects single-bit errors, they are reported only when the number of errors in the ECC single-bit error counter register equals

the threshold value in the ECC single-bit error trigger register. A memory select error occurs when a local memory transaction address falls outside of the physical memory boundaries as programmed in the memory boundary registers. A refresh overflow error occurs when no refresh transaction occurs within the equivalent of 16 refresh cycles.

In all cases, if the memory transaction is initiated by a PCI master, ErrDR1[3] is set; if the memory transaction is initiated by the processor core, ErrDR1[3] is cleared.

ErrDR2[7] is cleared to indicate that the error address in the processor/PCI error address register is valid. If the ECC single-bit error trigger threshold is reached, the error address indicates the address of the most recent ECC single-bit error. When a parity or ECC error occurs on the last beat of a transaction and another transaction to the same page has started, the MPC8245 cannot provide the error address and the corresponding bus status. In these cases, ErrDR2[7] is set to indicate that the error address in the processor/PCI error address register is not valid. Because the MPC8245 cannot provide the error address and the bus status for refresh overflow errors, ErrDR2[7] is set for these errors too.

If the processor core or a PCI master with bit 6 of the PCI command register cleared initiates the transaction, error status information is latched, but the transaction continues and terminates normally.

14.3.2.1 Memory Read Data Parity Error

When MCCR1[PCKEN] is set, the MPC8245 checks memory parity on every memory read cycle and generates the parity on every memory write cycle that emanates from the MPC8245. When a read parity error occurs, ErrDR1[2] is set.

The MPC8245 does not check parity for transactions in the local ROM address space.

NOTE

The processor should not check parity for local ROM space transactions because the parity data will be incorrect for these accesses.

14.3.2.2 Memory ECC Error

The MPC8245 can be configured to perform an ECC check on every memory read cycle, and it also generates the ECC check data on every memory write cycle. SDRAM systems use the in-line ECC configuration shown in Table 6-9.

When a single-bit ECC error occurs, the ECC single-bit error counter register is incremented by one and its value is compared to the value in the ECC single-bit error trigger register. If the values are equal, ErrDR1[2] is set. In addition to single-bit errors, the MPC8245 detects all 2-bit errors, all errors within a nibble (one-half byte), and any other multi-bit error that does not alias to either a single-bit error or no error. When a multi-bit ECC error occurs, ErrDR2[3] is set.

Write parity errors are reported in ErrDR1[2] (memory read parity error/ECC single-bit error exceeded). Read parity and multiple-bit ECC errors are reported in ErrDR2[3] (ECC multi-bit error).

14.3.2.3 Memory Select Error

A memory select error occurs when the address for a local memory transaction falls outside of the programmed boundaries of physical memory. When a memory select error occurs, ErrDR1[5] is set. If a write transaction causes a memory select error, the write data is ignored. If a read transaction causes the memory select error, the MPC8245 returns all ones (0xFFFF_FFFF). No $\overline{RAS}$/$\overline{CS}$ signals are asserted in either case.

14.3.2.4 Memory Refresh Overflow Error

When no refresh transactions occur for a period equal to 16 refresh cycles, the MPC8245 reports the error as a refresh overflow. When the MPC8245 detects a refresh overflow, ErrDR1[4] is set. See Section 6.2.12, “SDRAM Refresh.”

14.3.3 PCI Interface Errors

The MPC8245 supports the error detection and reporting mechanism as the *PCI Local Bus Specification*, Rev. 2.1, specifies. The MPC8245 keeps error information and sets appropriate error flags when a PCI error occurs (if the corresponding enable bit is set). The MPC8245 acts independently, whether or not the PCI command register is programmed to respond to or detect the specific error.

In cases of PCI errors, ErrDR1[3] is set to indicate that the error is due to a PCI transaction. In most cases, ErrDR2[7] is cleared to indicate that the error address in the processor/PCI error address register is valid. In these cases, the error address is the address that the PCI bus, rather than the processor core’s physical address.

If NMI is asserted, the MPC8245 cannot provide the error address and the corresponding bus error status. In such cases, ErrDR2[7] is set to indicate that the error address in the processor/PCI error address register is not valid.

14.3.3.1 PCI Address Parity Error

Bit 6 of the PCI command register controls whether the MPC8245 takes action when it detects an address or data parity error occurred. When the MPC8245 detects an address or data parity error, it sets bit 15 in the PCI status register, regardless of the settings in the PCI command register. Bit 7 of ErrEnR2 enables the reporting of PCI address parity errors to the processor core (through $\overline{mcp}$, if enabled).

Bit 8 of the PCI command register controls whether the MPC8245 asserts $\overline{\text{SERR}}$ upon detecting any PCI system error, including an address parity error. Whenever the MPC8245 asserts $\overline{\text{SERR}}$ to report a system error on the PCI bus, bit 14 of the PCI status register is set.

Bit 7 of ErrEnR1 enables the reporting (through $\overline{mcp}$, if enabled) of $\overline{\text{SERR}}$ assertion by an external agent on the PCI bus. If ErrEnR1[7] = 1 and the MPC8245 is acting as the initiator and an external PCI agent asserts $\overline{\text{SERR}}$ two clock cycles after the address phase, the error is recorded in bit 7 of ErrDR1 and a machine check is generated to the processor core.

14.3.3.2 PCI Data Parity Error

If the MPC8245 is acting as a PCI master and a data parity error occurs, the MPC8245 sets bit 15 of the PCI status register (independently) of the settings in the PCI command register.

If the PCI command register of the MPC8245 is programmed to respond to parity errors (bit 6 of the PCI command register is set) and a data parity error is detected or signaled during a PCI bus transaction, the MPC8245 sets the appropriate bits in the PCI status register (bit 15 is set, and possibly bit 8 is set, as the following paragraphs describe).

If the MPC8245 acting as the master (for example, during a processor-read-from-PCI transaction), bit 6 of the PCI command register is set, and a data parity error is detected, the MPC8245 reports the error to the PCI target by asserting $\overline{\text{PERR}}$ and setting bit 8 of the status register, and tries to complete the transaction if possible. Furthermore, if PICR1[MCP_EN] is set, the MPC8245 asserts $\overline{mcp}$ to report the error to the processor core. These actions also occur if the MPC8245 is the master and detects the assertion of $\overline{\text{PERR}}$ by the target (for a write).

If the MPC8245 is acting as a PCI target when the data parity error occurs (on a write), the MPC8245 asserts $\overline{\text{PERR}}$ and sets ErrDR1[6] (PCI target $\overline{\text{PERR}}$). If the data was transferred, the MPC8245 completes the operation but discards the data. Also, if PICR1[MCP_EN] is set, the MPC8245 asserts $\overline{mcp}$ to report the error to the processor core. If the master asserts $\overline{\text{PERR}}$ during a memory read, the address of the transfer is logged in the error address register and $\overline{mcp}$ is asserted (if enabled).

14.3.3.3 PCI Master-Abort Transaction Termination

If the MPC8245, acting as a master, initiates a PCI bus transaction (excluding special-cycle transactions), but no PCI agent gives a response ($\overline{\text{DEVSEL}}$ has not been asserted within five PCI bus clocks from the start of the address phase), the MPC8245 terminates the transaction with a master-abort and sets the master-abort flag (bit 13) in the PCI status register. Special-cycle transactions are normally terminated with a master-abort, but these terminations do not set the master-abort flag in the PCI status register.

If ErrEnR1[1] is set and the MPC8245 terminates a transaction with a master-abort, the MPC8245 reports the error to the processor core by asserting $\overline{mcp}$ (provided PICR1[MCP_EN] is set).

14.3.3.4 Received PCI Target-Abort Error

If target-abort terminates a PCI transaction that the MPC8245 initiates, the received target-abort flag (bit 12) of the PCI status register is set. If ErrEnR2[1] and PICR1[MCP_EN] are both set and the MPC8245 receives a target-abort, the MPC8245 reports the error to the processor core by asserting *mcp* (provided PICR1[MCP_EN] is set).

NOTE

Data that is transferred in a target-abort transaction could be corrupt.

14.3.3.5 NMI (Nonmaskable Interrupt)

If PICR1[MCP_EN] is set and a PCI agent asserts the NMI signal to the MPC8245, the MPC8245 reports the error to the processor core by asserting *mcp* if PICR1[MCP_EN] is set.

When the NMI signal is asserted, no error flags are set in the status registers of the MPC8245. The agent that drives NMI should provide the error flag for the system and the mechanism to reset that error flag. The NMI signal should remain asserted until the error flag is cleared.

14.3.4 Message Unit Error Events

A software programmable flag can cause the inbound portion of the message unit to assert *mcp*. Two overflow events on the inbound message queues can cause assertion of *mcp*. See Chapter 10, “Message Unit (with I_2O),” for more information about the message unit.

The MC bit in the IDBR allows a PCI master to generate a machine check interrupt (*mcp*) to the processor core.

The IMISR contains the interrupt status of the I_2O, doorbell, and message register events. These events are generated by PCI masters and are routed to the processor core from the message unit with the internal *int* or *mcp* signals. The specific bits in the IMISR that can cause *mcp* to be asserted are the outbound free_list overflow condition (OFO) and the inbound post_list overflow condition (IPO). In addition, the doorbell machine check condition IMISR[DMC] indicates that a PCI master set the IDBR[MC] bit.

The processor core interrupt handling software must service these interrupts and clear the interrupt bits. Software attempts to determine the source of the interrupts should always perform a logical AND between the IMISR bits and their corresponding mask bits in the IMIMR.

14.4 Exception Latencies

Latencies for taking various exceptions depend on the state of the MPC8245 when the conditions to produce an exception occur. The minimum latency is one cycle, and the exception is signaled in the cycle after the exception condition occurs.

Chapter 15
Power Management

A key feature of the MPC8245 and its predecessors, the MPC603e microprocessor and the MPC8240 integrated processor, is that they are designed for low-power operation. The MPC8245 provides both automatic and program-controllable power reduction modes for progressive reduction of power consumption. This chapter describes the support features that the MPC8245 provide for power management of the processor core and peripheral logic.

15.1 Overview

The MPC8245 has explicit power management features for both the processor core and peripheral logic that this chapter describes. Note that the design of the MPC8245 is fully static, allowing the internal logic states to be preserved during power management. The MPC8245 implementation offers the following enhancements to the original MPC603e family:

- Lower-power design
- 2.0-V core and 3.0 to 3.6-V I/O

Because operating systems service I/O requests by system calls to the device drivers, device drivers must be modified for power management. When a device driver is called to reduce the power of a device, it should be able to check the power state of the device, save the device configuration parameters, and put the device into a power-saving mode. Furthermore, if the device driver is called and if the device is in a power-saving mode, the driver needs to check the power status of the device and restore the device to the full-on state.

15.2 Processor Core Power Management

The processor core has various types of power management features. Dynamic power management occurs automatically (if enabled), depending on the activity of the execution units. The programmable doze, nap, and sleep modes provide further power savings. The power management features in the processor core are very similar to those in the MPC603e device.

15.2.1 Dynamic Power Management

Dynamic power management (DPM) automatically powers up and powers down the individual execution units of the MPC8245 processor core, depending on the contents of the instruction stream. For example, if no floating-point instructions are being executed, the floating-point unit (FPU) is automatically powered down. Power is not removed from the execution unit; instead, each execution unit has an independent clock input that is automatically controlled on a clock-by-clock basis. Because CMOS circuits consume negligible power when they are not switching, stopping the clock to an execution unit effectively eliminates its power consumption. The operation of DPM is transparent to software or any external hardware. Setting bit 11 in HID0 following a hard reset sequence enables DPM.

15.2.2 Programmable Power Modes on Processor Core

The peripheral logic block can wake up the processor from a low power state through the internal asynchronous interrupt ($\overline{int}$) signal (that the PIC unit generates), which transfers program flow to the interrupt handler code. The software then sets the appropriate mode. The MPC8245 provides a second interrupt signal and interrupt vector for power management—the system management interrupt ($\overline{SMI}$). The MPC8245 also contains a decrementer timer that allows it to enter the nap or doze mode for a specified period and then return to full-power operation through the decrementer interrupt exception.

Setting the appropriate control bits in the MSR and HID0 registers makes the following four processor power modes selectable:

- Processor full-power
- Processor doze
- Processor nap
- Processor sleep

Processor full-power is the default power state of the MPC8245. The MPC8245 is fully powered and the internal functional units are operating at full processor clock speed. If DPM is enabled, functional units that are idle automatically enter a low-power state without affecting performance, software execution, or external hardware.

In processor doze mode, all the functional units of the processor core are disabled except for the time base/decrementer registers and bus snooping logic. When the processor is in doze mode, an asynchronous interrupt (signaled by asserting $\overline{int}$), system management interrupt, decrementer exception, hard or soft reset, or any machine check exception brings the MPC8245 into the full-power state. The MPC8245 in doze mode maintains the phase-locked loop (PLL) in a fully powered state and is locked to the internal *sys_logic_clk* signal so a transition to the full-power state occurs within four processor clock cycles.

The processor nap mode further reduces power consumption when it disables the processor from bus snooping, leaving only the time base register and the PLL in a powered state. The MPC8245 returns to the full-power state on receipt of an interrupt (signaled by asserting $\overline{int}$), system management interrupt (signaled by asserting $\overline{SMI}$), decrementer exception, hard or soft reset, or any machine check exception. Also, negation of $\overline{QACK}$ (controlled by the peripheral logic block) causes the processor core to wake up from nap mode. A return to full-power state from a nap state occurs within four processor clock cycles.

The sleep mode reduces power consumption to a minimum by disabling all internal functional units, after which external logic can disable the PLL and the internal *sys_logic_clk* signal. The MPC8245 returns to the full-power state from sleep mode on receipt of an interrupt (signaled by asserting $\overline{int}$), system management interrupt, hard or soft reset, or any machine check exception. Also, negation of $\overline{QACK}$ (controlled by the peripheral logic block) causes the processor core to wake up from sleep mode.

External system logic must enable the processor PLL and the internal *sys_logic_clk* signal before any of the wake-up events occur. Refer to Section 15.3.2.4.2, “Disabling the PLL During Sleep Mode,” for more information about how the PLLs are locked and Section 2.3, “Clocking,” for more information about the clock signals of the MPC8245.

NOTE

The processor core cannot switch from one power-management mode to another without first returning to full-on mode. Table 15-1 summarizes the four power states for the processor.

Table 15-1. Programmable Processor Power Modes

PM Mode	Functioning Units	Activation Method	Full-Power Wake Up Method
Full power	All units active	—	—
Full power (with DPM)	Requested logic by demand	By instruction dispatch	—
Doze	• Bus snooping • Data cache as needed • Decrementer timer	Controlled by software (write to HID0)	• External asynchronous exceptions (assertion of $\overline{SMI}$ or $\overline{int}$) • Decrementer exception • Hard or soft reset • Machine check exception ($\overline{mcp}$)

Table 15-1. Programmable Processor Power Modes (continued)

PM Mode	Functioning Units	Activation Method	Full-Power Wake Up Method
Nap	Decrementer timer	Controlled by software (write to HID0) and qualified with $\overline{\text{QACK}}$ from peripheral logic	• External asynchronous exceptions (assertion of $\overline{\text{SMI}}$, or $\overline{int}$) • Decrementer exception • Negation of $\overline{\text{QACK}}$ by peripheral logic • Hard or soft reset • Machine check exception ($\overline{mcp}$)
Sleep	None	Controlled by software (write to HID0) and qualified with $\overline{\text{QACK}}$ from peripheral logic	• External asynchronous exceptions (assertion of $\overline{\text{SMI}}$, or $\overline{int}$) • Negation of $\overline{\text{QACK}}$ by peripheral logic • Hard or soft reset • Machine check exception ($\overline{mcp}$)

15.2.3 Processor Power Management Modes—Details

The following sections describe the characteristics of the MPC8245 power management modes, requirements for entering and exiting the various modes, and system capabilities that the processor core provides while the power management modes are active.

For the processor to enter nap or sleep mode, the software first programs the processor for one of those modes. Then the peripheral logic must be programmed for nap or sleep mode. When the peripheral logic is ready to nap or sleep, it signals that the processor can enter the nap or sleep mode and asserts the $\overline{\text{QACK}}$ output signal. If the peripheral logic wakes from nap or sleep (causing $\overline{\text{QACK}}$ to negate), the processor also wakes from nap or sleep mode.

15.2.3.1 Full-Power Mode with DPM Disabled

Full-power mode with DPM disabled is selected when the DPM enable bit (bit 11) in HID0 is cleared. The following characteristics apply:

- Default state follows assertion of $\overline{\text{HRST_CPU}}$ and $\overline{\text{HRST_CTRL}}$.
- All functional units are operating at full processor speed at all times.

15.2.3.2 Full-Power Mode with DPM Enabled

Without affecting the functionality or performance of the MPC8245, full-power mode with DPM enabled (HID0[11] = 1) provides on-chip power management as follows:

- Required functional units are operating at full processor speed.
- Functional units are clocked only when needed.
- No software or hardware intervention is required after mode is set.
- Software/hardware and performance are transparent.

15.2.3.3 Processor Doze Mode

Doze mode disables most functional units but maintains cache coherency by enabling bus snooping. A snoop hit causes the processor core to enable the data cache, copy the data back to memory, disable the cache, and fully return to the doze state.

Doze mode is characterized by the following features:

- Most functional units are disabled.
- Bus snooping and time base/decrementer are still enabled.
- PLL is running and locked to the internal *sys_logic_clk* signal.

To enter the doze mode, the following conditions must occur:

- Set doze bit (HID0[8] = 1).
- The MPC8245 enters doze mode after several processor clocks.

To return to full-power mode, the following conditions must occur:

- Internal $\overline{int}$ or $\overline{MCPO}$ signals are asserted to the processor by the peripheral logic block, NMI asserted, $\overline{SMI}$ asserted, or decrementer exception.
- Hard reset or soft reset is done.

Transition to full-power state occurs within four processor cycles.

15.2.3.4 Processor Nap Mode

The nap mode disables the processor core except for the processor PLL and time base/decrementer. The time base can be used to restore the processor core to full-on state after a specified period.

Because bus snooping is disabled for nap and sleep mode, the peripheral logic block delays the processor from entering into nap mode until all the peripheral logic internal buffers are flushed and no outstanding transaction awaits. Also, software must ensure that no PCI master accesses main memory, unless software can guarantee that none of the accesses would correspond to a modified line in the L1 cache.

When the peripheral logic block ensures that snooping is no longer necessary, it allows the processor to enter the nap or sleep mode and causes the assertion of the MPC8245 $\overline{QACK}$ output signal for the duration of the nap mode period.

The following features characterize nap mode:

- Time base/decrementer is still enabled.
- Most functional units are disabled (including bus snooping).
- PLL is running and locked to the internal *sys_logic_clk* signal.

To enter the nap mode, the following conditions must occur:

- Set nap bit (HID0[9] = 1).
- The processor asserts internal request for nap or sleep mode to the peripheral logic.
- Peripheral logic must be programmed for nap or sleep mode.
- MPC8245 asserts quiesce acknowledge ($\overline{\text{QACK}}$) output signal after flushing the internal buffers in peripheral logic block.
- The processor core enters nap mode after several processor clocks. (Peripheral logic also enters the nap or sleep mode.)

To return to full-power mode, the following conditions must occur:

- Internal $\overline{int}$ or $\overline{mcp}$ signals are asserted or $\overline{\text{QACK}}$ is negated by the peripheral logic block, $\overline{\text{SMI}}$ asserted, or decrementer exception
- Hard reset or soft reset is done.

Transition to full-power occurs within four processor cycles.

15.2.3.5 Processor Sleep Mode

Sleep mode consumes the least amount of power of the four modes since all functional units are disabled. To conserve the maximum amount of power, the processor PLL and internal *sys_logic_clk* signals can be disabled to the processor. Because the MPC8245 has fully static design, internal processor state is preserved when no internal clock is present. Because the time base and decrementer are disabled while the processor is in sleep mode, the time base contents must be updated from an external time base following sleep mode if accurate time-of-day maintenance is required.

As in nap mode, the peripheral logic block delays the processor from entering into sleep mode until all the internal buffers are flushed and no outstanding transaction are waiting. When the peripheral logic block ensures that snooping is no longer necessary, it allows the processor core to enter sleep mode and asserts the $\overline{\text{QACK}}$ output signal for the duration of the sleep mode period.

Sleep mode is characterized by the following:

- All processor functional units are disabled (including bus snooping and time base).
- All nonessential input receivers are disabled.
- Internal clock regenerators are disabled.
- Processor PLL and the internal *sys_logic_clk* signal can be disabled.

To enter sleep mode, the following conditions must occur:

- Set sleep bit (HID0[10] = 1).
- The processor asserts internal request for nap or sleep mode to the peripheral logic.
- The peripheral logic must be programmed for nap or sleep mode.

- MPC8245 asserts quiesce acknowledge ($\overline{\text{QACK}}$) output signal after flushing the internal buffers of peripheral logic block.
- Processor core enters sleep mode after several processor clocks. (Peripheral logic also enters the nap or sleep mode.)

To return to full-power mode, the following conditions must occur:

- Internal $\overline{int}$ or $\overline{mcp}$ signals are asserted.
- The peripheral logic block, NMI asserted, or $\overline{\text{SMI}}$ asserted negate $\overline{\text{QACK}}$.
- Hard reset or soft reset is done.

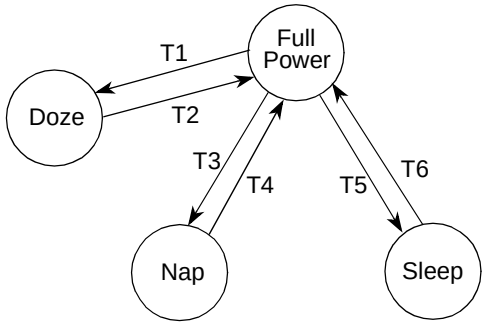
15.2.4 Power Management Software Considerations

Because the processor core is a dual-issue processor with out-of-order execution capability, take care when entering the processor power management modes. Furthermore, nap and sleep modes require all outstanding bus operations to be completed before the processor power management mode is entered. Section 15.5, “Example Code Sequence for Processor and Peripheral Logic Sleep Modes,” provides an example software sequence for putting the processor core into sleep mode.

15.3 Peripheral Logic Power Management

Like the power management features of the processor core, the peripheral logic block of the MPC8245 has its own doze, nap, and sleep modes, which are described in the following sections.

Figure 15-1 shows the four power states of the MPC8245 peripheral logic block (three programmable power-saving modes plus full-power) and the conditions required for entering and exiting those modes. The three programmable power-saving modes provide different levels of power savings. Doze, nap, and sleep are entered through software by setting the corresponding configuration register bit in the power management control register one (PMCR1). For more information about this register, see Section 4.3.1, “Power Management Configuration Register 1 (PMCR1)—Offset 0x70.” In addition, the PMCR1[PM] global power management bit must be set to one to enable any of the power saving modes of the peripheral logic block.



T1: PMCR1(DOZE) = 1 and PMCR1(PM) = 1
T2: Hard Reset, $\overline{BRx}$ = 0, PCI Address Hit, NMI
T3: PMCR1(NAP) = 1 and PMCR1(PM) = 1 and [proc_NAP (or SLEEP) Request]
T4: Hard Reset, $\overline{BRx}$ = 0, PCI address hit, NMI
T5: PMCR1(SLEEP) = 1 and PMCR1(PM) = 1 and [proc_NAP (or SLEEP) Request]
T6: Hard Reset, $\overline{BRx}$ = 0, NMI

Figure 15-1. MPC8245 Peripheral Logic Power States

15.3.1 MPC8245 Peripheral Power Mode Transitions

Before the peripheral logic can enter into either nap or sleep mode, the processor must have requested to enter either nap or sleep mode. If the processor wakes up from nap or sleep, the peripheral logic also wakes up from nap or sleep.

In doze, nap, and sleep modes, the peripheral logic always monitors the internal bus request signal from the processor core. For example, when it is asserted because the decrementer exception occurred, the peripheral logic exits its low power state and goes back to the full-power state to service the request.

The MPC8245 does not support the broadcast of PCI special cycles related to low-power operation. The PMCR1[NO_NAP_MSG] and PMCR1[NO_SLEEP_MSG] bits must be set by initialization software (which are cleared on reset) to indicate that the MPC8245 does not broadcast the HALT or sleep message commands on the PCI bus before entering the nap or sleep modes.

Table 15-2 summarizes the functionality and transition criteria of the peripheral logic block in all power states.

Table 15-2. Peripheral Logic Power Modes Summary

PM Mode	Functioning Units	Activation Method	Full-Power Wake-Up Method
Full power	All units active	—	—
Doze	• PCI address decoding and bus arbiter • System RAM refreshing • Processor bus request and NMI monitoring • PIC unit • I^2C unit • DUART unit • PLL	Controlled by software (write to PMCR1)	• PCI access to memory • Processor bus request • Assertion of NMI [1] • Interrupt to PIC • Hard reset
Nap	• PCI address decoding and bus arbiter • System RAM refreshing • Processor bus request and NMI monitoring • PIC unit • I^2C unit • DUART unit • PLL	Controlled by software (write to PMCR1) and processor core in nap or sleep mode ($\overline{\text{QREQ}}$ asserted)	• PCI access to memory [2] • Processor bus request • Assertion of NMI[1] • Interrupt to PIC • Hard reset
Sleep	• PCI bus arbiter • System RAM refreshing (can be disabled) • Processor bus request and NMI monitoring • PIC unit • I^2C unit • DUART unit • PLL (can be disabled)	Controlled by software (write to PMCR1) and processor core in nap or sleep mode ($\overline{\text{QREQ}}$ asserted)	• Processor bus request • Assertion of NMI[1] • Interrupt to PIC • Hard reset

[1] Programmable option based on value of PICR1[MCP_EN] = 1.

[2] A PCI access to memory in nap mode causes $\overline{\text{QACK}}$ to negate while the MPC8245 services the access. After servicing the PCI access, the peripheral logic automatically returns to the nap mode.

15.3.2 Peripheral Power Management Modes

The following sections describe characteristics of the MPC8245 peripheral power management modes, requirements for entering and exiting the various modes, and system capabilities that the processor core provides while power management modes are active.

15.3.2.1 Peripheral Logic Full-Power Mode

The default power state of the MPC8245 is full-power. In this state, the peripheral logic block is fully powered and the internal functional units are operating at full clock speed.

15.3.2.2 Peripheral Logic Doze Mode

The doze mode is entered when PMCR1[DOZE] and PMCR1[PM] are set and no operations are pending for the MPC8245. In this power-saving mode, all functional units

of the peripheral logic block are disabled except for PCI address decoding, PCI bus arbiter, system RAM refreshing, processor bus request monitoring, and NMI signal monitoring. Also, the PIC, DUART, and I^2C units continue to function.

The peripheral logic is brought out of doze state mode into full-power state mode by one of the following:

- A PCI transaction referenced to the system memory
- A processor bus request, the assertion of NMI (provided PICR1[MCP_EN] = 1)
- Assertion of $\overline{int}$ from the PIC unit (due to an interrupt condition into the PIC unit)
- A hard reset

NOTE

Note that other processor exceptions (for example, the assertion of the $\overline{SMI}$ signal) cause processor bus cycles that indirectly cause the peripheral logic to wake up from doze mode.

After the request is serviced, the peripheral logic goes back to the doze state unless PMCR1[DOZE] or PMCR1[PM] are cleared or other operations are pending.

In doze mode, the PLL is fully operational and locked to PCI_SYNC_IN. The transition to the full-power state occurs within four processor clock cycles. The peripheral logic doze mode operates totally independently from the power-saving state of the processor.

15.3.2.3 Peripheral Logic Nap Mode

Further power-saving from doze mode can be guaranteed through the peripheral logic nap mode because the peripheral logic does not enter the nap mode unless the processor core is ready to enter either nap or sleep mode. The peripheral logic nap mode is entered when PMCR1[NAP] and PMCR1[PM] are set and the processor core is ready to nap or sleep. When this occurs, the peripheral logic responds, entering the nap mode and asserting the $\overline{QACK}$ output.

As in peripheral logic doze mode, all peripheral logic functional units are disabled in nap mode except for PCI address decoding, PCI bus arbiter, system RAM refreshing, processor bus request monitoring, and NMI signal monitoring. Also, the PIC, DUART, and I^2C units continue to function.

The peripheral logic is brought out of nap mode into full-power mode by one of the following:

- A PCI transaction referenced to the system memory
- A processor bus request assertion of NMI (provided PICR1[MCP_EN] = 1)
- Assertion of $\overline{int}$ from the PIC unit (due to an interrupt condition into the PIC unit)

- A hard reset

If any of these causes except for a PCI transaction awakens the peripheral logic, it is serviced, $\overline{\text{QACK}}$ negates (waking up the processor core), and PMCR1[PM] is cleared to prevent the peripheral logic from automatically re-entering the nap state.

15.3.2.3.1 PCI Transactions During Nap Mode

When the peripheral logic is awakened from the nap state by a PCI-agent initiated transaction, it is serviced, PMCR1[PM] remains set, $\overline{\text{QACK}}$ negates, and the peripheral logic goes back to the nap state.

If the MPC8245 is temporarily awakened to service a PCI transaction, the processor core does not respond to any snoop cycles. Therefore, software should flush the L1 cache before allowing the peripheral logic to enter the nap mode, if the system allows PCI accesses to wake up the peripheral logic without guaranteeing that the processor will snoop incoming PCI transactions.

15.3.2.3.2 PLL Operation During Nap Mode

In peripheral logic nap mode, the PLL is fully operational and locked to PCI_SYNC_IN. The transition to the full-power state occurs within four processor clock cycles.

15.3.2.4 Peripheral Logic Sleep Mode

Compared to the nap mode, peripheral logic sleep mode provides further power saving. As it does with nap mode, the peripheral logic does not enter sleep mode unless the processor core has requested to enter either nap or sleep mode. The sleep mode is entered when PMCR1[SLEEP] and PMCR1[PM] are set and the processor core is ready to nap or sleep. When this occurs, the peripheral logic responds by entering sleep mode and asserting the $\overline{\text{QACK}}$ output. It is important to guarantee that no new PCI transactions occur before PMCR1 is programmed for sleep mode because PCI transactions are not serviced in peripheral logic sleep mode.

When the peripheral logic is in sleep mode, the only functional units operating are the on-chip PCI bus arbiter, system RAM refreshing logic (enabled by PMCR1[LP_REF_EN] for sleep mode), processor bus request monitoring, NMI signal monitoring, PIC unit, DUART unit, and I^2C unit. All other units are shut down.

Similar to nap mode, the following conditions bring the peripheral logic out of sleep mode and into the full-power state: a processor bus request, the assertion of NMI (provided PICR1[MCP_EN] = 1), the assertion of $\overline{\textit{int}}$ from the PIC unit (due to an interrupt condition into the PIC unit), or a hard reset. PMCR1[PM] is always cleared after the core logic is awakened from the sleep state.

Note that the PLL_CFG[0:4] pins are sampled when the MPC8245 is waking from sleep mode only if PMCR2[SLEEP] = 1.

15.3.2.4.1 System Memory Refresh During Sleep Mode

When the peripheral logic is in sleep mode, the system memory contents can be maintained either by enabling the memory's self-refresh mode or by having the operating system copy all the memory contents to the hard disk before the peripheral logic enters the sleep state. Alternatively, the MPC8245 refresh logic can continue to perform the refresh function in sleep mode if PMCR1[LP_REF_EN] is set. In this case, MCCR1[SREN] is used to determine whether the refresh is a self-refresh (SREN = 1) or a CBR refresh (SREN = 0). If LP_REF_EN is cleared, the refresh operations stop when the MPC8245 enters the sleep mode.

When the MPC8245 is in the sleep state using CBR refresh and keeping the PLL in operation, the wake-up latency is comparable to that of nap mode (within four processor clock cycles). However, if the system uses the self-refresh mode or turns off the PLL during the sleep state, additional wake-up latency is incurred.

15.3.2.4.2 Disabling the PLL During Sleep Mode

When the peripheral logic is in sleep mode, an external power-management controller (PMC) may disable the PLL for the peripheral logic block and the PCI_SYNC_IN input for further power saving. Setting the PLL_CFG(0:4) pins to the PLL bypass mode can disable the PLL. See the *MPC8245 Integrated Processor Hardware Specifications* for detailed information about PLL modes. Disabling the PLL or PCI_SYNC_IN input during sleep mode should not occur until after the assertion of the $\overline{\text{QACK}}$ output ensures that the processor is in either nap or sleep mode.

If the peripheral logic PLL is disabled, the external PMC chip should trap all the wake-up events so that it can turn on the PLL (to guarantee the relock time) or the PCI_SYNC_IN input before forwarding the wake-up event to the MPC8245. When recovering from sleep mode, the external PMC must re-enable the PLL and PCI_SYNC_IN first and then wake up the MPC8245 (using any of the wake-up methods) after 100 µs of PLL relock time.

15.3.2.4.3 SDRAM Paging During Sleep Mode

SDRAM systems that have paging mode enabled must disable paging mode before entering sleep mode to avoid memory loss and corruption. After the peripheral logic exits sleep mode and returns to the full-power state, paging mode can be enabled again.

15.4 Disabling Peripheral Clocks

Disabling peripheral clocks can save power too. When the clocks are disabled, I/O signals do not switch, and less power is consumed.

15.5 Example Code Sequence for Processor and Peripheral Logic Sleep Modes

The following is a sample code sequence for putting the processor core and peripheral logic into sleep mode. Note that no-op instructions make the code read and execute in program order despite the address munging that causes little-endian addressing of instructions that are already in the cache. If the processor is operating in big-endian mode, these no-op instructions are not needed.

```
**********************************************************************
# First set up peripheral logic power management register
# and the processor core HID0 power management bits
#**********************************************************************
#**********************************************************************
# turn on power management bits
#
        addis       r3, r0, 0x8000      # start building new register number
        ori         r3, r3, 0x0070      # register number 0xf0
        stwbrx      r3, r0, r1          # write this value to CONFIG_ADDR
        sync
        lhbrx       r4, r0, r2          # load r4 from CONFIG_DATA
        addis       r0, r0, 0x0000      # PM=1
        ori         r0, r0, 0xc088      # set bits 15, 14, and 7, 3(sleep)
        or          r4, r4, r0          # set the PM bit
        sync
        sthbrx      r4, r0, r2          # write the modified data to
                                         CONFIG_DATA
        sync

#******processor HID and external interrupt initialization******************
#
# set up HID registers for the various processors
# hid setup taken from minix's mpxPowerPC.s

        mfspr   r31, pvr         # pvr reg
        srawi    r31, r31, 16
resetTest603:
        cmpi    0, 0, r31, 3
        bne     cr0, endHIDSetup

        addi    r0, r0, 0
        oris    r0, r0, 0x1000   # enable machine check pin EMCP
        oris    r0, r0, 0x0010   # enable dynamic power mgmt DPM
        oris    r0, r0, 0x0020   # enable SLEEP power mode
        ori     r0, r0, 0x8000   # enable the Icache ICE
        ori     r0, r0, 0x4000   # enable the Dcache DCE
        ori     r0, r0, 0x0800   # invalidate Icache ICFI
        ori     r0, r0, 0x0400   # invalidate Dcache DCFI
        mtspr   hid0, r0
        isync
```

```
#*****************************************************************
# then when the processor is in a loop, force an SMI interrupt
#*****************************************************************

.orig 0x00001400                        # System management interrupt

# force big-endian mode
        stw         r0,0x05f8,r0        # need nop every second inst to make
                                        # code read and execute in program
                                         order (up until the isync).
        stw         r0,0x05fc,r0
        mfmsr       r0
        ori         r0,r0,r0
        ori         r0,r0,0x0001        # force big-endian LE bit
        ori         r0,r0,r0
        xori        r0,r0,0x0001        # force big-endian LE bit
        ori         r0,r0,r0
        mtmsr       r0
        ori         r0,r0,r0
        isync
        ori         r0,r0,r0

# save off additional registers to be corrupted
        stw         r20,0x05f4,r0
        mfspr       r21, srr0           # put srr0 in r21
        stw         r21,0x05f0,r0       # put r21 in 0x05f0
        mfspr       r22, srr1           # put srr1 in r22
        stw         r22,0x05ec,r0       # put r22 in 0x05ec
        stw         r23,0x05e8,r0
        mfcr        r23
        stw         r23,0x05e4,r0
        xor         r0,r0,r0

#*****************************************************************
# set msr pow bit to go into sleep mode

        sync
        mfmsr r5                        # get MSR
        addis r3, r0, 0x0004            # turn on POW bit
        ori   r3, r3, 0x0000            # turn on ME bit 19
        or    r5, r3, r5
        mtmsr r5
        isync

        addis r20, r0, 0x0000
        ori   r20, r20, 0x0002
stay_here:
        addic.  r20, r20, -1            # subtract 1 from r20 and set cc
        bgt cr0, stay_here              # loop if positive


# restore corrupted registers
        lwz         r23,0x05e4,r0
        mtcrf       0xff,r23
```

```
        lwz         r23,0x05e8,r0
        lwz         r22,0x05ec,r0
        mtspr       srr1, r22
        lwz         r21,0x05f0,r0
        mtspr       srr0, r21
        lwz         r20,0x05f4,r0
        lwz         r0,0x05fc,r0

        sync
        rfi

#*****************************************************************
# to get out of sleep mode, do a Soft Reset
#*****************************************************************


.orig 0x00000100                        # Reset handler in low memory

# force big-endian mode
        stw         r0,0x05f8,r0        # need nop every second inst to make
                                        # code read and execute in program
                                         order (up until the isync).
        stw         r0,0x05fc,r0
        mfmsr       r0
        ori         r0,r0,r0
        ori         r0,r0,0x0001        # force big-endian LE bit
        ori         r0,r0,r0
        xori        r0,r0,0x0001        # force big-endian LE bit
        ori         r0,r0,r0
        mtmsr       r0
        ori         r0,r0,r0
        isync
        ori         r0,r0,r0

# save off additional registers to be corrupted
        stw         r20,0x05f4,r0
        stw         r21,0x05f0,r0
        stw         r22,0x05ec,r0
        stw         r23,0x05e8,r0
        mfcr        r23
        stw         r23,0x05e4,r0
        xor         r0,r0,r0

# restore corrupted registers
        lwz         r23,0x05e4,r0
        mtcrf       0xff,r23
        lwz         r23,0x05e8,r0
        lwz         r22,0x05ec,r0
        lwz         r21,0x05f0,r0
        lwz         r20,0x05f4,r0
        lwz         r0,0x05fc,r0

        sync
```

```
        rfi
#*****************************************************************
```

Chapter 16
Performance Monitor

The MPC8245's core logic contains a facility that monitors bridge logic events such as SDRAM or PCI bus traffic, the DUART, or the number of interrupts emanating from an interrupt controller. The performance monitor can be used for the following:

- To optimize overall system performance by monitoring bridge logic events
- To characterize the MPC8245 behavior in any system or software environment because some systems or software environments are not easily characterized by signal traces or benchmarks
- To help system developers bring up and debug their systems

16.1 Overview

The performance monitor uses the following run-time registers in the embedded utility memory block:

- Performance monitor counter registers (PMC0–PMC3); 32-bit counters that count the times a software-selectable event has occurred.
- Command registers (CMDR0–CMDR3) that select the counter, the type of event, the event to be counted, and the threshold for that event
- Monitor mode control register (MMCR) that controls the operation of the performance monitor counters

16.2 Performance Monitor Registers

The performance monitor incorporates the registers that Table 16-1 shows.

Table 16-1. Performance Monitor Register Summary

PCI Memory Offset	Local Memory Offset	Register Name	Description
0xe00	0xf_e000	Command register 0 (CMDR0)	Allows software to set up threshold, type, and event for counter 0.
0xe04	0xf_e004	Command register 1 (CMDR1)	Allows software to set up threshold, type, and event for counter 1.

Table 16-1. Performance Monitor Register Summary (continued)

PCI Memory Offset	Local Memory Offset	Register Name	Description
0xe08	0xf_e008	Command register 2 (CMDR2)	Allows software to set up threshold, type, and event for counter 2.
0xe0c	0xf_e00c	Command register 3 (CMDR3)	Allows software to set up threshold, type, and event for counter 3.
0xe10	0xf_e010	Performance monitor count 0 (PMC0)	Contains the count for counter 0.
0xe14	0xf_e014	Performance monitor count 1 (PMC1)	Contains the count for counter 1.
0xe18	0xf_e018	Performance monitor count 2 (PMC2)	Contains the count for counter 2.
0xe1c	0xf_e01c	Performance monitor count 3 (PMC3)	Contains the count for counter 3.
0xe20	0xf_e020	Monitor mode control register (MMCR)	Allows software to control the different performance monitor modes.

16.2.1 Command Registers (CMDR[0:3])

The performance monitor command registers (CMDR0–MCDR3) are readable and writable registers for selecting the type of event, the event to be counted, and the threshold for that event. The CMDR registers can be accessed as a 32-bit, 4-byte register or as entire words. Table 16-2 shows the performance monitor command register bit settings.

The four CMDRs set up all four counters, one per each counter. If all four counters should start simultaneously, each counter is configured by writing to its CMDR. Counting is enabled by setting MMCR[ENABLE]. CMDR[THRESHOLD] specifies the threshold value for PMC0 and PMC1 threshold events. Because PMC2 and PMC3 do not support threshold events, a threshold value is meaningless for these counters.

Table 16-2. Command Register (CMDR)

Bits	Name	Reset Value	R/W	Description
31-16	THRESHOLD	16’b0	RW	Threshold value for PMC0 and PMC1 only. This field is meaningless for PMC2 and PMC3.
15	COMMAND TYPE	1’b0	RW	Selects the command type, which is used to define the possible event types. 0: Command type 0. Events to count are selected according to Table 16-5. See Section 16.3.1, “Command Type 0 Events” for more information. 1: Command type 1. Events to count are selected according to Table 16-6 on page 8. See Section 16.3.2, “Command Type 1 Events for more information.
14-8	—			Reserved
7-0	EVENT	8’b0	RW	Denotes which event to count. See Table 16-5 and Table 16-6 for the possible events that correspond to the chosen counter and command type.

16.2.2 Monitor Mode Control Register (MMCR)

The performance monitor mode control register (MMCR) is a 32-bit readable and writable register for controlling performance monitor operation. The MMCR register is reset to zero at power on. Reading this register does not change its contents. The MMCR can be accessed as a 2-byte register or a 4-byte word. Table 16-3 shows register bit settings for performance monitor mode control.

Counters can be cascaded to 64 bit-configuration. Enabling MMCR[OVERFLOW_01] configures PMC0 and PMC1 as a single counter counting the event programmed in CMDR0. Figure 16-1 shows a diagram of PMC0 and PMC1 configured to utilize overflow. Enabling MMCR[OVERFLOW_23] configures PMC2 and PMC3 as a single counter that counts the event programmed in CMDR2. Disabled count and counter trigger are not supported when the counters are cascaded.

Note that this overflow option requires MMCR[PMCTRIG] = 0 and MMCR[DISCOUNT] = 0.

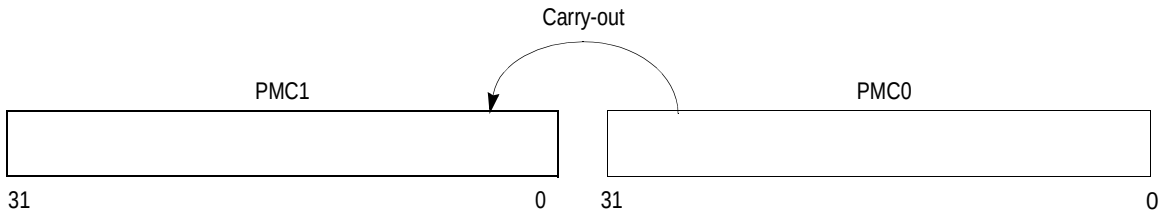


Figure 16-1. Overflow Example

Setting the MMCR[DISCOUNT] bit can disable all counters when any counter reaches a negative value (most significant bit is set).

By setting MMCR[PMCTRIG], PMC0 can trigger the counting of PMC1, PCM2, and PMC3. The trigger occurs when PMC0 reaches a negative value (and most significant bit is set).

The MMCR[ENABLE] bit starts the performance monitor counting. When the performance monitor is enabled, the CMDRs should be programmed and the PMCs are initialized to the desired start value.

Table 16-3. Monitor Mode Control Register (MMCR)

Bits	Name	Reset Value	R/W	Description
31-16	—			Reserved
15	OVERFLOW_01	1'b0	RW	Overflow PMC0 into PMC1. Setting this bit allows PMC0 and PMC1 to be cascaded and become a 64-bit counter. Note that this overflow option requires MMCR[PMCTRIG] = 0 and MMCR[DISCOUNT] = 0.

Table 16-3. Monitor Mode Control Register (MMCR) (continued)

Bits	Name	Reset Value	R/W	Description
14	OVERFLOW_23	1'b0	RW	Overflow PMC2 into PMC3. Setting this bit allows PMC2 and PMC3 to be cascaded to become a 64-bit counter. Note that this overflow option requires MMCR[PMCTRIG] = 0 and MMCR[DISCOUNT] = 0
13-8	—			Reserved
7	ENABLE	1'b0	RW	Count enable. This bit enables the performance monitor facility. 0 Disable event counting for all counters 1 Enable event counting for all counters
6	DISCOUNT	1'b0	RW	Disable counter for msb bit. This bit determines the counting behavior of all counters when any counter reaches a negative value (most significant bit is set). 0 No effect on the counters 1 PMC0 is disabled and PMCn (n>0) are disabled if MMCR[PMCTRG] = 0
5-1	—			Reserved
0	PMCTRIG	1'b0	RW	Performance monitor counter trigger. This bit determines the behavior of PMC1, PMC2, and PMC3 after PMC0 reaches a negative value (most significant bit is set). 0 No effect on PMC1, PMC2, and PMC3 1 Disable PMC1, PMC2, and PMC3 counting until the msb of PMC0 is asserted PMCTRG may trigger counting of PMC*n* (n>0) after PMC0 has become negative to provide a triggering mechanism to allow counting after a certain condition occurs or after enough time has elapsed. It can be used to support getting the count associated with a specific event.

16.2.3 Performance Monitor Counter (PMC0–PMC3)

Using the configuration registers discussed in Section 16.2.1, "Command Registers (CMDR[0:3])," the four performance monitor counters can count the occurrences of specific events. Using the four different counters, four different events can be counted simultaneously. CMDR[0:3] are used to select the events to be counted and the counters that hold the events. The MMCR controls the counters' behavior.

PMC0–PMC3, shown in Figure 16-2, are 32-bit read/writable counters that hold the count for each event. Only PMC0 and PMC1 support threshold events.

Counters PMC0 and PMC1 can be configured to become one 64-bit counter, and counters PMC2 and PMC3 can become one 64-bit counter. Enabling bits MMCR[OVERFLOW_01] or MMCR[OVERFLOW_23] and disabling bits MMCR[DISCOUNT] and MMCR[PMCTRG] configures the counters to 64-bit. Note that the carryout from PMC0 is used, rather than the most significant bit.

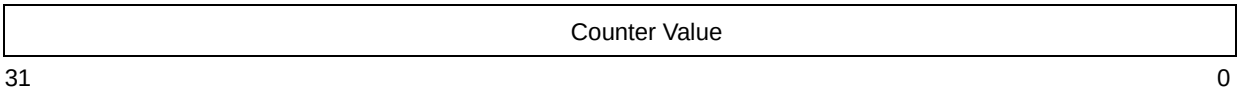


Figure 16-2. Performance Monitor Counter Registers (PMC0–PMC3)

Table 16-4 describes the bits in the PMC registers.

Table 16-4. PMC*n* Field Descriptions

Bits	Name	Description
31–0	Count	Counter value. Indicates the number of occurrences of the specified event.

Counters overflow when the high-order bit (the sign bit) rolls over to 0 from 0xffff-ffff.

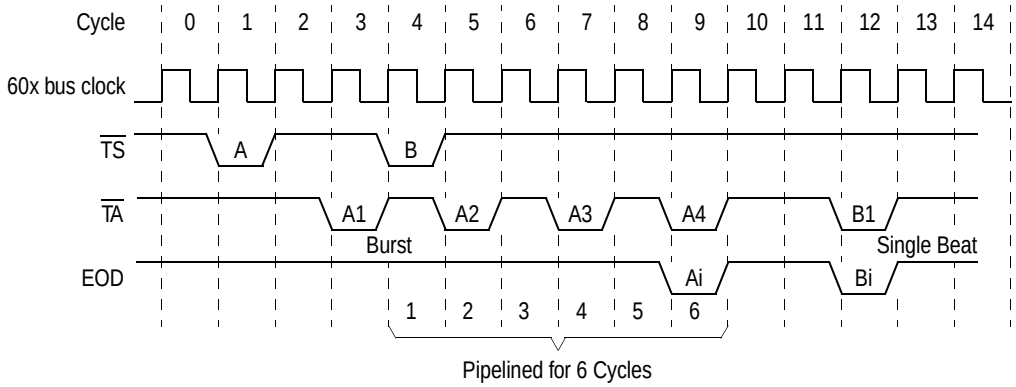
16.3 Event Selection

Two types of events, command type 0 and command type 1, can be counted. The CMDR[CMD_TYPE] parameter selects the command type. The eight-bit event parameter CMDR[EVENT] specifies which events are counted. The meaning of the event parameter varies, depending on the command type selected.

Before describing performance monitor events, note term definitions. The following terms are used throughout this section:

End-of-data (EOD) EOD is the clock cycle of the last data transfer for a transaction. For burst transactions, EOD occurs on the fourth assertion of $\overline{\text{TA}}$. For single-beat transactions, EOD occurs on the first (and only) assertion of $\overline{\text{TA}}$. Figure 16-3 shows example of EOD for both burst- and single-beat transactions.

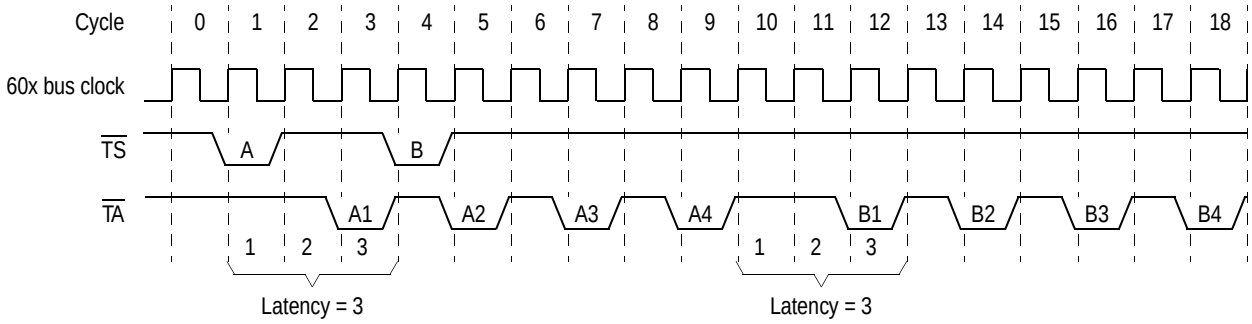
Pipelined For processor transactions, pipelining occurs when $\overline{\text{TS}}$ is asserted before the previous transaction's EOD. Figure 16-3 shows an example of a pipelined processor transaction.
For memory transactions, pipelining occurs when the MPC8245 internally starts a system memory transaction before the previous memory transaction has completed.



Because transaction A is a burst transaction, the EOD occurs on the fourth $\overline{TA}$. Transaction B is a single beat transaction; so the EOD occurs at the first and only $\overline{TA}$. Note that transaction B is a pipelined transaction, because the $\overline{TS}$ of transaction B comes before the EOD of the previous transaction, A.

Figure 16-3. Pipelined Processor Transaction and End-of-Data (EOD)

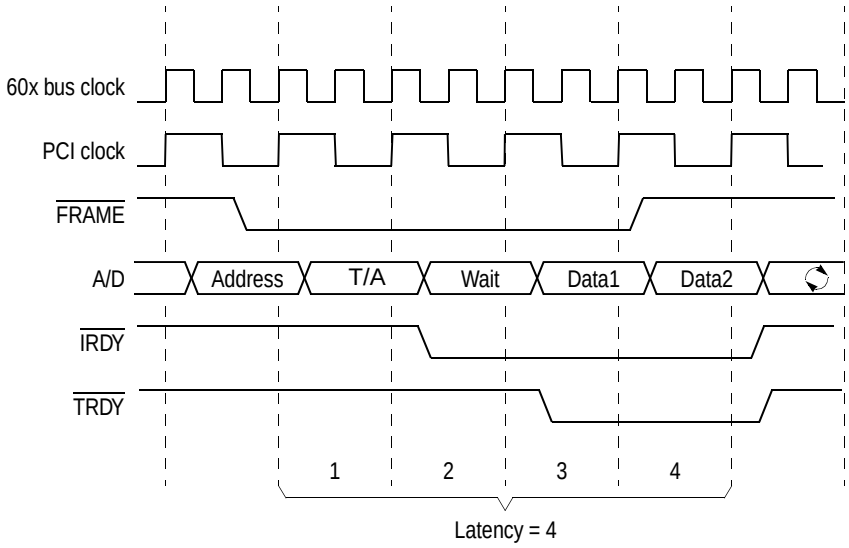
Processor latency Processor latency is the number of clock cycles between, and including, the assertion of $\overline{TS}$ and the first assertion of $\overline{TA}$. For pipelined transactions, latency is the number of clock cycles between, and including, the clock cycle following the previous transaction's EOD and the first assertion of $\overline{TA}$ (see Figure 16-4).



Transaction A shows a non-pipelined transaction. Transaction B shows a pipelined transaction.

Figure 16-4. Processor Latency

PCI latency PCI latency is the number of PCI clock cycles between and including the assertion of $\overline{\text{FRAME}}$ and the first PCI clock cycle that data is valid ($\overline{\text{IRDY}}$ and $\overline{\text{TRDY}}$ asserted) (see Figure 16-5).



Latency is counted starting with the cycle $\overline{\text{FRAME}}$ is asserted and counted until the first data is valid.

Figure 16-5. PCI Latency

16.3.1 Command Type 0 Events

Command type 0 events are specified with CMDR[CMD_TYPE] = 0. These events can be counted only in PMC0 and PMC1 (PMC2 and PMC3 cannot be used because all command type 0 events are threshold events—see Section 16.3.3, “Threshold Events,” for more information). All command type 0 events are processor transactions.

The 63 valid command type 0 events are each defined by the transaction type, destination, and transaction size bits that Table 16-5 shows. The three possible transaction types are read, write, and read/write. The seven possible transaction destinations include system memory, PCI, ROM, system memory/PCI, PCI/ROM, and so forth, and the three possible transaction sizes are burst, single-beat, and burst/single-beat. Every command type 0 event must have at least one defined transaction type, one defined destination, and one defined transaction size. Processor snoop copy-backs and retried processor transactions are not counted.

Table 16-5. Command Type 0—Processor Transactions

CMDR	Bit	Name	Description
EVENT	7	READ	Read transaction type bit. Enables counting of read transactions. 0 Disable counting of read transactions 1 Enable counting of read transactions
	6	WRITE	Write transaction type bit. Enables counting of write transactions. 0 Disable counting of write transactions 1 Enable counting of write transactions
	5	—	Reserved
	4	MEMORY	Memory destination bit. Enables counting of transactions with system memory as the target. 0 Disable counting events targeted at system memory 1 Enable counting events targeted at system memory
	3	PCI	PCI destination bit. Enables counting of transactions with PCI-mapped addresses including EUMBBAR and internal configuration registers as the target 0 Disable counting events targeted at PCI 1 Enable counting events targeted at PCI
	2	ROM	ROM destination bit. Enables counting of transactions with LOCAL ROM as the Target. 0 Disable counting events targeted at ROM 1 Enable counting events targeted at ROM
	1	BURST	Burst transaction size bit. Enables counting of burst transactions. 0 Disable counting of burst transactions 1 Enable counting of burst transactions
	0	SINGLE_BT	Single-beat transaction size bit. Enables counting of single beat transactoins. 0 Disable counting of single beat transactions 1 Enable counting of single beat transactions

16.3.2 Command Type 1 Events

Command type 1 events are specified with CMDR[CMD_TYPE] = 1. Table 16-6 shows definitions of command type 1 events. Most command type 1 events can be counted by all four counters. However, as Table 16-6 specifies, some events can be counted only in PMC0 and PMC1, and others are countable only in PMC2 and PMC3. Note that all events are counted in 60x bus cycles or system bus cycles, except PCI events, which are counted in PCI cycles.

Table 16-6. Command Type 1—Event Encodings

Event (decimal)	Event (hex)	Counter PMC*n*	Description
Processor Transactions			
0	00	0,1,2, or 3	Counter holds current value
1	01	0,1,2, or 3	Number of 60x cycles

Table 16-6. Command Type 1—Event Encodings (continued)

Event (decimal)	Event (hex)	Counter PMC*n*	Description
2	02	0 or 1	$\overline{TA}$ overlap. Number of cycles from the $\overline{TS}$ to the last $\overline{TA}$ of the previous transaction in pipelined situations. Note that the counter increments only if the number $\overline{TA}$ overlap cycles is greater than the threshold value.
3	03	0,1,2, or 3	Cache-inhibited transactions that are not retried
4-6	04-06	—	Reserved
7	07	0,1,2, or 3	**Sync** and **eieio** instructions that are not retried
8	08	0,1,2, or 3	Address-only transactions (**sync**,**eieio**,Kill,**icbi**,Clean,Flush,**tlbi**,**lwarx**,**stwcx**,**tlbsync**) that are not retired
9	09	0 or 1	Number of cycles between $\overline{BR0}$ and $\overline{BG0}$ (qualified). Note that the counter increments only if the number of cycles from a bus request until a bus grant is qualified, including the cycles the signals are asserted, is greater than the threshold value.
10	0A	—	Reserved
11	0B	0,1,2, or 3	Number of cycles that the 60x address bus is busy (includes all address phases)
12	0C	0,1,2, or 3	Number of cycles that the 60x data bus is busy (includes all data transfers)
13	0D	0,1,2, or 3	Number of retries issued by the core logic on the 60x bus
14	0E	—	Reserved
15	0F	0,1,2, or 3	Number of retries issued to the core logic on the 60x bus
16	10	0,1,2, or 3	Number of cycles that the memory interface is busy reading from ROM
17	11	0,1,2, or 3	Number of cycles that the memory interface is busy reading from system memory
18	12	0,1,2, or 3	Number of cycles that the memory interface is busy performing reads and writes (from both system memory and ROM)
19	13	—	Reserved
20	14	0 or 1	Number of cycles that the processor waits while a PCI transaction is occurring Note that the counter increments if the number of cycles the processor waits while a PCI transaction is occurring is greater than the threshold value.
21	15	0 and 1	Burstiness for processor transactions. PMC0 counts the number of times there are X transactions in a row with an acceptable latency of Y cycles. Note that this event involves PMC0 and PMC1.
22-31	16-1F	—	Reserved
PCI Transactions			
32	20	0,1,2,or 3	Number of PCI cycles
33	21	0 or 1	Number of PCI read from memory commands (memory-read, memory-read-line, and memory-read-multiple). Note that the counter increments if the number of cycles from the start of the transaction until the first data is greater than the threshold value.

Table 16-6. Command Type 1—Event Encodings (continued)

Event (decimal)	Event (hex)	Counter PMC*n*	Description
34	22	0,1,2, or 3	Number of PCI read and write to memory commands (memory-read, memory-read-line, and memory-read-multiple, memory-write and memory-write-invalidate) by external PCI master or internal DMAs
35	23	0,1,2, or 3	Number of data beats read by external PCI master
36	24	0,1,2, or 3	Number of data beats read and written by external PCI master
37	25	0,1, 2, or 3	Number of PCI memory-read-line commands by external PCI master and DMAs
38	26	0,1,2, or 3	Number of PCI memory-read-multiple commands by external PCI master and DMAs
39	27	0,1,2, or 3	Number of PCI reads from Local ROM space by external master
40	28	0,1,2, or 3	Number of PCI memory-write-and-invalidate commands by external master and DMAs
41	29	0,1,2, or 3	Number of speculative PCI read snoops
42	2A	0,1,2, or 3	Number of PCI read and speculative PCI read snoops
43	2B	0,1,2, or 3	Number of PCI write, PCI read, and speculative PCI read snoops
44	2C	0,1,2, or 3	Number of PCI reads that hit the PCI-to system-memory-read-buffer (PCMRB) while the core logic is still trying to fill it after a disconnect. When a PCI read is attempted but the latency exceeds 32 PCI cycles, the core logic must disconnect as required by the PCI specification. MPC8245 assumes that the PCI master will return with a request to the same address and continues the line fill from system memory. Event 44 occurs if the PCI master issues a read command to the same cache line, while the line fill is still in progress
45	2D	0,1,2 or 3	Number of PCI reads that hit in the PCMRB while MPC8245 is still busy performing a speculative fetch of that line.
46	2E	0,1,2, or 3	Number of PCI reads that hit in the PCMRB
47	2F	0,1,2, or 3	Number of PCI reads that hit modified cache lines in the processor's L1 cache
48	30	0,1,2, or 3	Number of PCI reads and PCI writes that hit modified cache lines in the processor's L1 cache
49	31	0,1,2, or 3	Number of PCI transactions that disconnected at the end of a cache line
50	32	0, 1, 2, or 3	Number of PCI idle cycles
51	33	0, 1, 2, or 3	Number of PCI wait cycles
52	34	0, 1, 2, or 3	Number of PCI retries before transaction is successful
53	35	0, 1, 2, or 3	Number of disconnects on a PCI read
54	36	0, 1, 2, or 3	Number of PCI address phases
55-58		—	Reserved
59	3B	0 and 1	Burstiness for PCI transactions. PMC0 counts the number of times there are X transactions in a row with an acceptable latency of Y cycles. Note: This event involves PMC0 and PMC1
60	3C	0, 1, 2, or 3	Number of PCI cycles that FRAME_ is asserted

Table 16-6. Command Type 1—Event Encodings (continued)

Event (decimal)	Event (hex)	Counter PMC*n*	Description
61	3D	0, 1, 2, or 3	Number of PCI cycles that IRDY_ is asserted
62	3E	0, 1, 2, or 3	Number of PCI cycles that TRDY_ is asserted
63-66		—	Reserved
67	43	0, 1, 2, or 3	Number of PCI cycles that MPC8245 is using the bus
68	44	0, 1, 2, or 3	Number of PCI cycles that device 0 is using the bus
69	45	0, 1, 2, or 3	Number of PCI cycles that device 1 is using the bus
70	46	0, 1, 2, or 3	Number of PCI cycles that device 2 is using the bus
71	47	0, 1, 2, or 3	Number of PCI cycles that device 3 is using the bus
72	48	0, 1, 2, or 3	Number of PCI cycles that device 4 is using the bus
73-79		—	Reserved
Local Memory Transactions			
80	50	2 or 3	Number of pipelined read misses to page 0
81	51	2 or 3	Number of pipelined read and write misses to page 0
82	52	2 or 3	Number of non-pipelined read misses to page 0
83	53	2 or 3	Number of non-pipelined read and write misses to page 0
84	54	2 or 3	Number of pipelined read hits to page 1—SDRAM only
85	55	2 or 3	Number of pipelined read and write misses to page 1—SDRAM only
86	56	2 or 3	Number of non-pipelined read misses to page 1—SDRAM only
87	57	2 or 3	Number of non-pipelined read and write misses to page 1—SDRAM only
88	58	2 or 3	Number of pipelined read hits to page 0
89	59	2 or 3	Number of pipelined read and write hits to page 0
90	5A	2 or 3	Number of non-pipelined read hits to page 0
91	5B	2 or 3	Number of non-pipelined read and write hits to page 0
92	5C	2 or 3	Number of pipelined read hits to page 1—SDRAM only
93	5D	2 or 3	Number of pipelined read and write hits to page 1—SDRAM only
94	5E	2 or 3	Number of non-pipelined read hits to page 1—SDRAM only
95	5F	2 or 3	Number of non-pipelined read and write hits to page 1—SDRAM only
96	60	2 or 3	Number of forced closings for page 0 (excluding refreshes)
97	61	2 or 3	Number of forced closings for page 1 (excluding refreshes)—SDRAM only
98	62	2 or 3	Total number of misses to page 0, 1, 2, and 3, pipelined and non-pipelined
99	63	2 or 3	Total number of hits to page 0, 1, 2, and 3, pipelined and non-pipelined
100	64	2 or 3	Total number of forced closings for page 0 and page 1

Table 16-6. Command Type 1—Event Encodings (continued)

Event (decimal)	Event (hex)	Counter PMC*n*	Description
101	65	2 or 3	Number of pipelined read hits to page 2—SDRAM only
102	66	2 or 3	Number of pipelined read and write misses to page 2—SDRAM only
103	67	2 or 3	Number of non-pipelined read misses to page 2—SDRAM only
104	68	2 or 3	Number of non-pipelined read and write misses to page 2—SDRAM only
105	69	2 or 3	Number of pipelined read hits to page 3—SDRAM only
106	6A	2 or 3	Number of pipelined read and write misses to page 3—SDRAM only
107	6B	2 or 3	Number of non-pipelined read misses to page 3—SDRAM only
108	6C	2 or 3	Number of non-pipelined read and write misses to page 3—SDRAM only
109	6D	2 or 3	Number of pipelined read hits to page 2—SDRAM only
110	6E	2 or 3	Number of pipelined read and write hits to page 2—SDRAM only
111	6F	2 or 3	Number of non-pipelined read hits to page 2—SDRAM only
112	70	2 or 3	Number of non-pipelined read and write hits to page 2—SDRAM only
113	71	2 or 3	Number of pipelined read hits to page 3 — SDRAM only
114	72	2 or 3	Number of pipelined read and write hits to page 3 — SDRAM only
115	73	2 or 3	Number of non-pipelined read hits to page 3 — SDRAM only
116	74	2 or 3	Number of non-pipelined read and write hits to page 3 — SDRAM only
117	75	2 or 3	Number of forced closings for page 2 (excluding refreshes) — SDRAM only
118	76	2 or 3	Number of forced closings for page 3 (excluding refreshes) — SDRAM only
119-128	77-80	—	Reserved
I^2C Transactions			
129	81	0, 1, 2, or 3	Number of cycles that the bus is busy
130	82	0, 1, 2, or 3	Number of times addressed as a slave
131	83	0, 1, 2, or 3	Number of times arbitration lost
132	84	0, 1, 2, or 3	Number of times data transfer is complete. This counts the number of address phase and data phase completions
133	85	0, 1, 2, or 3	Number of interrupts
134	86	0, 1, 2, or 3	Number of cycles interrupt active
135	87	0, 1, 2, or 3	Number of no acknowledges
136-139	88-8B	—	Reserved
DMA Transactions			
140	8C	0, 1, 2, or 3	Number of cycles that channel 0 is busy
141	8D	0, 1, 2, or 3	Number of cycles that channel 1 is busy
142	8E	0, 1, 2, or 3	Number of cycles elapsed since a periodic DMA 0 began

Table 16-6. Command Type 1—Event Encodings (continued)

Event (decimal)	Event (hex)	Counter PMC*n*	Description
143	8F	0, 1, 2, or 3	Number of cycles elapsed since a periodic DMA 1 began
144	90	0 or 1	Number of cycles elapsed since a specified segment of a DMA 0 in chaining mode began Note1: Threshold needs to be set to segment #, where first segment = 1 Note2: If both PMC0 and PMC1 are programmed for this event but with different segments, the result will be the count of both segments.
145	91	0 or 1	Number of cycles elapsed since a specified segment of a DMA 1 in chaining mode began Note1: Threshold needs to be set to segment #, first segment = 1 Note2: If both PMC0 and PMC1 are programmed for this event but with different segments, the result will be the count of both segments
146-147	92-93	—	Reserved
148	94	0, 1, 2, or 3	Number of cycles of interrupt latency for DMA 0
149	95	0, 1, 2, or 3	Number of cycles of interrupt latency for DMA1
150-169	96-A9	—	Reserved
I2O Transactions			
170	AA	0, 1, 2, or 3	Number of cycles of interrupt latency for outbound interrupts
171	AB	0, 1, 2, or 3	Number of cycles of interrupt latency for inbound interrupts
172-189	AC-BD	—	Reserved
PIC Transactions			
190	BE	0, 1, 2, or 3	Number of cycles the activity bit is set for discrete/serial interrupt source 0
191	BF	0, 1, 2, or 3	Number of cycles the activity bit is set for discrete/serial interrupt source 1
192	C0	0, 1, 2, or 3	Number of cycles the activity bit is set for discrete/serial interrupt source 2
193	C1	0, 1, 2, or 3	Number of cycles the activity bit is set for discrete/serial interrupt source 3
194	C2	0, 1, 2, or 3	Number of cycles the activity bit is set for discrete/serial interrupt source 4
195	C3	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 5
196	C4	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 6
197	C5	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 7
198	C6	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 8
199	C7	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 9
200	C8	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 10
201	C9	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 11
202	CA	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 12
203	CB	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 13
204	CC	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 14

Table 16-6. Command Type 1—Event Encodings (continued)

Event (decimal)	Event (hex)	Counter PMC*n*	Description
205	CD	0, 1, 2, or 3	Number of cycles the activity bit is set for serial interrupt source 15
206	CE	0, 1, 2, or 3	Number of cycles the activity bit is set for I^2C interrupt
207	CF	0, 1, 2, or 3	Number of cycles the activity bit is set for I2O interrupt
208	D0	0, 1, 2, or 3	Number of cycles the activity bit is set for DMA Channel 0 interrupt
209	D1	0, 1, 2, or 3	Number of cycles the activity bit is set for DMA Channel 1 interrupt
210	D2	0, 1, 2, or 3	Number of cycles the activity bit is set for UART 1 interrupt
211	D3	0, 1, 2, or 3	Number of cycles the activity bit is set for UART 2 interrupt
212	D4	0, 1, 2, or 3	Number of cycles the activity bit is set for timer 0 interrupt
213	D5	0, 1, 2, or 3	Number of cycles the activity bit is set for timer 1 interrupt
214	D6	0, 1, 2, or 3	Number of cycles the activity bit is set for timer 2 interrupt
215	D7	0, 1, 2, or 3	Number of cycles the activity bit is set for timer 3 interrupt
216	D8	0, 1, 2, or 3	Number of cycles int_ is asserted
217-229	D9-E6	—	Reserved
DUART Transactions			
230	E6	0, 1, 2, or 3	Number of UART1 cycles of interrupt latency to PIC
231	E7	0, 1, 2, or 3	Number of UART2 cycles of interrupt latency to PIC
232	E8	0, 1, 2, or 3	Number of UART1 cycles of interrupt latency to PCI
233	E9	0, 1, 2, or 3	Number of UART2 cycles of interrupt latency to PCI
234	Ea	0, 1, 2, or 3	Number of UART1 baud cycles. Note that UAFR1[bit 1] must be set.
235	Eb	0, 1, 2, or 3	Number of UART2 baud cycles. Note that UAFR2[bit 1] must be set.
236-255	ED-FF	—	Reserved

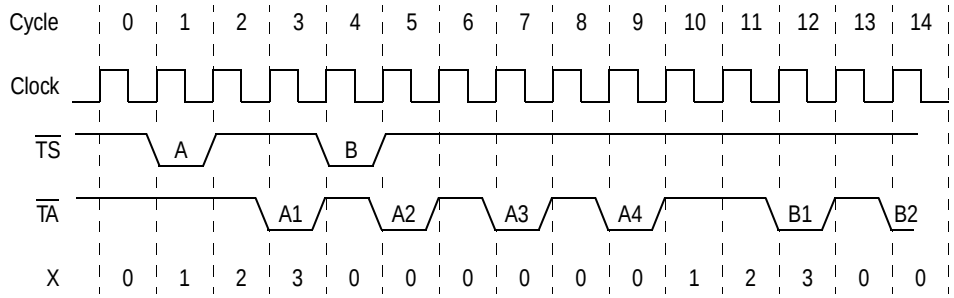
16.3.3 Threshold Events

The intent of threshold support is to be able to characterize events that can take a variable number of cycles to occur. Command type 0 threshold events are counted only if the latency is greater than the threshold value CMDR[THRESHOLD].

Figure 16-6 shows an example of a command type 0 event with threshold.

NOTE

PMC0 and PMC1 are the only counters that support counting threshold events. PMC2 and PMC3 do not support threshold events.



These two transactions (a non-pipelined transaction ‘A’ and a pipelined transaction ‘B’) both have a latency of 3 and are both counted as events if the threshold value is 0, 1, or 2 (that is, X > CMDR[THRESHOLD]).

Figure 16-6. Command Type 0 Threshold Example

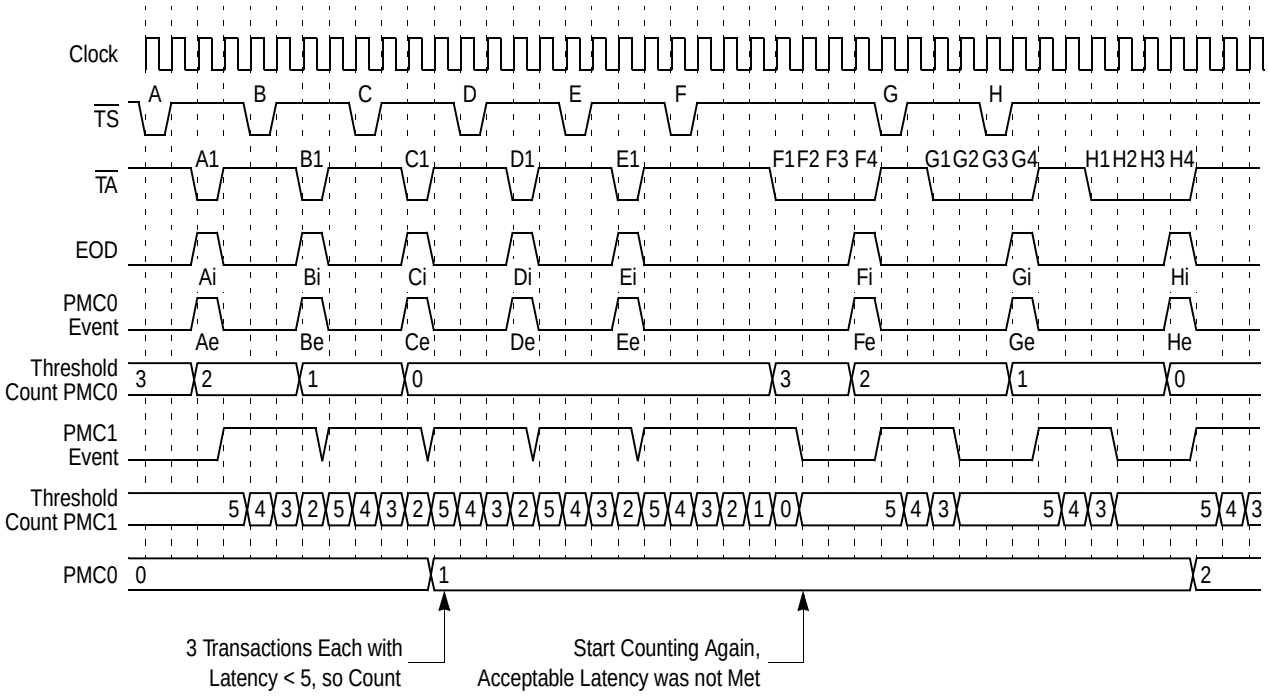
The eight-command type 1 threshold events are events 2, 9, 20, 21, 33, 59, 144, and 145. The event descriptions in Table 16-6 describe how threshold is used for those events.

16.3.4 Burstiness

Burstiness is a special command type 1 event that involves both PMC0 and PMC1. When configured correctly, it enables PMC0 to count the number of times that at least *X* transactions are in a row with an acceptable latency of *Y* clock cycles between any two transactions. For example, burstiness can count the number of times that 1,000 writes to PCI in a row occur, each with less than or equal to nine cycles of latency between them.

To count burstiness, PMC0 is configured to count the command type 0 processor transactions of interest (see Table 16-5 on page 16-8). The threshold of PMC0 is set to be the minimum number of consecutive transactions desired (called *X* above). PMC1 is configured to count command type 1 and event 21 (see Table 16-6). The threshold of PMC1 is set to the acceptable latency desired (called *Y* above). PMC0 operates as a normal command type 0 event until counter 1 is configured for event 21. Note that the latency to the first transaction is not considered. Because burstiness does not require using counter 1, it may be useful to enable MMCR[OVERFLOW_01] to allow overflow and create a 64-bit counter.

Figure 16-7 shows an example of a burstiness event that counts the number of times at least three processor transactions occur in a row with an acceptable latency of 4 cycles between each transaction. In this example, *X* is 3 and *Y* is 4. The threshold of PMC0 is set to *X*, and the threshold of PMC1 is set to *Y*.



PMC0 Threshold = 3
(*X*, Minimum Number of Transactions)

PMC0:
Command Type = 0, Event = 0xFF, Threshold = 0x0003

PMC1 Threshold = 5
(*Y*, Acceptable Latency)

PMC1:
Command Type = 1, Event = 0x21, Threshold = 0x0005

NOTE: Because *X* is the minimum number of transactions, even if 2,000 transactions occur each with an acceptable latency of 5, the value in PMC0 is still only 1. The acceptable latency has to be violated before the counter can be eligible to increment again.

Figure 16-7. Processor Burstiness Example

16.4 Performance Monitor Examples

This section describes some examples of using the performance monitor on the MPC8245. The covered topics include DUART baud rate and baud rate error, interrupt latencies, PCI performance, and DMA performance measurements.

16.4.1 Determining UART Baud Rate

The performance monitor can help determine the baud rate of the UARTs in the MPC8245. Because the internal system clock clocks UARTs, software must calculate the divisor based on that clock. The configuration register 0xe0 bits (23:19) provides the PLL setting. A lookup table can help determine the standard system clock for a given PCI frequency at that

setting. If the PCI frequency is unknown, using the baud rate error to derive the divisor can solve the problem.

16.4.1.1 Measuring the UART Baud Rate Error

Using event “Number of UART Baud Cycles” with a reference clock can measure the baud rate, number of UART clocks per second error. Note that the register UAFR[1] must be set for these events to work. Programming the reference clock for a one-second period with a 32.768 kHz clock counts about 32768 (0x7FA6).

To measure the UART baud rate error, do the following:

- Using the disable count feature (MMCR[DISCOUNT] = 1), set the reference counter PMC2 to 0x7fff_805A (0x8000_0000 minus 0x7FA6). The PLL setting indicates a system clock to be 100MHz. UART1 has a divisor of 651 (0x028b) for a baud rate of 9600 and UART2 has a divisor of 107 (0x006b) for a baud rate of 57300.
- Program PMC0 to count the type 1 event 234 (0xea) “number of UART1 baud clocks” and PMC1 to count the type 1 event 235 (0xeb) “number of UART2 baud clocks.”

As an example calculation, suppose the actual system clock is running at 98.4 MHz instead of 100 MHz. How much error would the baud clocks have?

The end results in Table 16-7 show the baud clock for UART1 in PMC0 is 9429 (0x24d5), a percentage error of about –2.0 percent. PMC1 shows that UART2 with a baud clock of 56315 (0xdbfd) also produced an error of about –2.0 percent. This information can help to adjust the divisor slightly to reduce the percent error. Adjusting divisor1 to 0x027e and divisor2 to 0x0069 causes a percentage error of less than one percent for both baud rates.

new_UART1_divisor = orig_divisor x (1 + error) = 651 x (1 + -0.02) = 638 = 0x027e

new_UART2_divisor = orig_divisor x (1 + error) = 107 x (1 + -0.02) = 105 = 0x0069

Table 16-7. DUART Baud Rate Error Example

Register	Init Programming	End Result
Performance Monitor		
CMDR0	0x0000_80ea	—
CMDR1	0x0000_80eb	—
CMDR2	0x0000_8077	—
PMC0	0x0000_0000	0x0000_24d5 (=9429)
PMC1	0x0000_0000	0x0000_dbfb (=56315)
PMC2	0x7fff_805a	0x8000_0000
MMCR	0x0000_00c0	—

Table 16-7. DUART Baud Rate Error Example (continued)

Register	Init Programming	End Result
DUART		
UDLB1	0x8b	—
UDMB1	0x02	—
UAFR1	0x02	—
UDLB2	0x6b	—
UDMB2	0x00	—
UAFR2	0x02	—

16.4.2 Interrupt Latency

The performance monitor can measure interrupt latency in the MPC8245, monitoring the interrupts to the CPU and the PCI bus for many different sources. This section describes an example of a DMA interrupt to the CPU.

1. Determine the latency for the CPU to recognize, service, and clear a DMA interrupt. To make this determination, do the following:

   Set the performance monitor to count the number of cycles of interrupt latency for DMA0, the number of cycles the activity bit is set for DMA0, and the number of cycles int_ is active.
2. Generate an interrupt in a non-nested interrupt system by doing the following:
   a) Program PMC0 to count the type 1 event 148 (0x94) “Number of cycles of interrupt latency for DMA0”.
   b) Set up PMC1 to count the type 1 event 208 (0xd0) “number of cycles DMA0 activity bit is set.”
   c) Set up PMC2 to count the type 1 event 216 (0xd8) “number of int_ asserted.”

Table 16-8 shows the performance monitor register settings for this example and the end results. To generate an interrupt for a non-nested interrupt system, the sequence of events is as follows:

1. PMC0 starts counting when the DMA0 generates an interrupt.
2. PMC1 starts counting a few cycles later when PIC sets the DMA0 activity bit.
3. PMC2 starts counting when PIC interrupts the CPU.
4. When the CPU sees the external interrupt, it takes an exception. When the machine state is saved, the CPU does a read acknowledge from PIC, causing PMC2 to stop counting.
5. The returned vector from PIC is analyzed and a service routine is provoked. When the service routine clears all active interrupts in the DMA0 status register, PMC0 stops counting.
6. An end-of-interrupt (EOI) is issued to PIC when the DMA0 service routine has completed, causing the DMA0 interrupt to be removed from the in-service register and clearing the DMA0 activity bit. At that point, PMC1 stops counting.

PMC2 provides information about the time it takes for the CPU to save the machine state and recognize the interrupt. This information may be useful in determining if the interrupt handler should be optimized further or cache should be way locked in the instruction cache.

Depending on how the service routine is written, PMC0 provides the amount of time it takes to service the interrupt. This information may be used too for optimization purposes.

PMC1 provides the total time it takes to service the interrupt minus the restoring of the machine state. This information may be useful for real time systems in analyzing if tasks make or miss a deadline.

Table 16-8. Interrupt Latency Example

Register	Init Programming	End Result
CMDR0	0x0000_8094	—
CMDR1	0x0000_80d0	—
CMDR2	0x0000_80d8	—
PMC0	0x0000_0000	0x0000_007b (=123)
PMC1	0x0000_0000	0x0000_0085 (=133)
PMC2	0x0000_0000	0x0000_001e (=30)
MMCR	0x0000_0080	—

16.4.3 PCI Performance

Much time is spent analyzing the PCI bus. Measurements like utilization, efficiency, and throughput can be taken with the MPC8245 performance monitor. This section describes how to use the performance monitor to obtain each measurement.

The following definitions are useful:

- *Utilization* is the number of used clocks per total number of clocks.
- *Efficiency* is how well the device uses the given bandwidth.
- *Throughput* is defined as the number of transferred bytes in a given period of time. Throughput can also be derived by multiplying utilization with efficiency.

The following PCI sample can be used to describe each of these measurements further.

IDLE
ADDR PHASE
WAIT
DATA
DATA
WAIT
DATA
WAIT
DATA
IDLE

In this sample, utilization is eight used clocks out of 10 total clocks. Efficiency is four data cycles out of eight used cycles. Throughput is four data cycles out of 10 total cycles.

Throughput = Utilization x Efficiency = 8/10 x 4/8 = 4/10

The following sections show how to use the performance monitor to calculate each of these measurements. This information can be used to adjust the priorities of the PCI arbiter and increase overall system performance.

16.4.3.1 PCI Utilization

PCI bus utilization is the number of used clocks per total number of clocks. The MPC8245 provides specific PCI type 1 events for calculating bus utilization. Event 32 “Number of PCI cycles” and event 50 “Number of IDLE cycles” can help determine overall bus utilization by taking the total number of clocks minus the number of IDLE cycles. When the MPC8245 is the PCI arbiter, the performance monitor also provides individual device utilization through events 67 to 72. These events do not need additional calculations.

For example, to determine the overall bus utilization and how much of that is the MPC8245’s and how much is Device 0’s, a PCI snapshot can be taken by using the disable

count mode (MMCR[DISCOUNT]=1) on the type 1 event 32 (0x20) “Number of PCI cycles” in PMC0. To get such a snapshot, set up the following:

- PMC1 for the type 1 event 50 (0x32) “Number of IDLE cycles”
- PMC2 with the type 1 event 67 (0x43) “Number of MPC8245 is using bus”
- PMC3 with the type 1 event 68 (0x44) “Number of cycles device0 is using bus”
- Enable the performance monitor and run a test program.

Table 16-9 shows results in overall utilization to be 2,147,483,648 (0x8000_0000) minus 35,422,934 (0x021c_82d6) that is equal to 2,112,060,714 (0x7de3_7d2a) cycles or 98 percent of the total sampled. Of those used cycles, the MPC8245 and Device 0 are using less than one percent. This test can be repeated by monitoring Devices 1 to 4 to determine which device is utilizing the bus.

Percent_Utilized = (PCI_CYC - IDLE) / (PCI_CYC)

Percent_Utilized = (2,112,060,714) / (2,147,483,648) = 98 percent

Table 16-9. PCI Utilization Example

Register	Init Programming	End Result
CMDR0	0x0000_8020	—
CMDR1	0x0000_8032	—
CMDR2	0x0000_8043	—
CMDR3	0x0000_8044	—
PMC0	0x0000_0000	0x8000_0000 (=2147483648)
PMC1	0x0000_0000	0x021c_82d6 (=35422934)
PMC2	0x0000_0000	0x0001_9032 (=102450)
PMC3	0x0000_0000	0x0000_0de0 (=3552)
MMCR	0x0000_00c0	—

16.4.3.2 PCI Efficiency

PCI efficiency is the competency or proficiency of a device or devices using a given bandwidth. Efficiency is much more difficult to obtain than bus utilization because efficiency is also pertains to the amount of data that is transferred per data beat. The performance monitor cannot distinguish the difference between one byte or four bytes of data during a transferred data beat. The assumption is that all beats transfer four bytes of data. Furthermore, the performance monitor does not measure the number of valid data beats, that is, TRDY and IRDY low. Another assumption is that the initiator or PCI master does not generate a wait cycle. With these assumptions, the following equation can describe one way for the performance monitor to measure PCI efficiency.

Efficiency = (Data Beats) / (Used Clocks) = (IRDY - WAITS) /(PCI_CYC - IDLE)

For example, to determine the overall efficiency of the PCI bus for a sampled period of time, given that all data beats are of four bytes and that the initiator does not generate a wait cycle, do the following:

- Set PMC0 to count the type 1 event 32 (0x20) “number of PCI cycles”.
- Turn on the disable count mode (MMCR[DISCOUNT]=1) to obtain a PCI sample of 4000 cycles.
- Set up PMC1 to count the type 1 event 50 (0x32) “number of IDLE cycles” for deriving the number of used clocks.
- Set up PMC2 to count the type 1 event 61 (0x3d) “number of IRDY_”.
- Set up PMC3 up to count the type 1 event 51 (0x33) “number of wait states”.
- Use PMC2 and PMC3 to derive the number of valid data beats.

Table 16-10 shows the end results: an approximate efficiency can be derived by dividing the number of actual data beats by the number of used clocks. A result of 96 percent shows that the devices are efficiently using the available bandwidth.

Efficiency = (IRDY - WAITS)/(PCI_CYC - IDLE) = (3088-24)/(4000-820) = 96 percent

Table 16-10. PCI Efficiency Example

Register	Init Programming	End Result
CMDR0	0x0000_8020	—
CMDR1	0x0000_8050	—
CMDR2	0x0000_8061	—
CMDR3	0x0000_8051	—
PMC0	0x7fff_f060	0x8000_0000 (=2147483648)
PMC1	0x0000_0000	0x0000_0334 (=820)
PMC2	0x0000_0000	0x0000_0c10 (=3088)
PMC3	0x0000_0000	0x0000_0018 (=24)
MMCR	0x0000_00c0	—

16.4.3.3 PCI Throughput

The throughput is the number of transferred bytes over a time period. It can also be described as bus efficiency times bus utilization. The MPC8245 performance monitor cannot distinguish between transfers of one byte and four bytes and valid data beats without some assumptions. Using the PCI Efficiency example above, throughput can be calculated as the number of bytes per clock divided by total number of clocks as shown in the following equation:

Throughput = (Data beats x 4 bytes per beat) / (Total PCI cycles)

Throughput = ((IRDY - WAIT) x4) / (PCI_CYC)

Throughput = ((3088-24) x 4) / (4000) = 3.06 bytes/cycle

Throughput_percent = (3.06 bytes/cycle) / (4 bytes_max/cycle) = 76.5 percent

In the example, throughput is calculated to be 3.06 bytes per cycles. If the PCI bus frequency was 33 MHz, throughput would be 102.13 Mb/sec. Using the throughput equation to check the results shows the following:

Throughput = Efficiency x Utilization

Utilization = Throughput / Efficiency = 0.765 / 0.96 = 0.79

vs.

Utilization = (PCI_CYC - IDLE) / PCI_CYC = 3180 / 4000 = 0.79

16.4.4 DMA Performance

The performance monitor can measure DMA performance, particularly the number of cycles that the DMA is busy and can measure performance on a single segment in a chain. This section examines both performance measurements.

Because the DMA events are based on the system clock, the system-to-PCI clock ratio must be used to derive the DMA throughput with a PCI transfer. Use configuration register 0xe bits(23:19) to determine the clock ratio. Also note that the DMA performance greatly depends upon the CPU and PCI activity.

16.4.4.1 DMA Channel Busy

Determine the DMA performance transferring four Kbytes of data from a PCI device that cannot support continuous data streaming without a wait cycle to local memory. The bus ratio used for this example was 3:1 or 33 (PCI):100 (system).

- Set up the performance monitor with PMC0 monitoring type 1 event 140 (0x8c) “number of cycles DMA0 is busy.”
- Using equation 6, calculate the maximum theoretical value for a 33MHz PCI transfer to be 133 Mb/sec.

  PCI_max_through_put = (PCI_clk x bytes_per_pci_data_beat)

  PCI_max_through_put = (33MHz x 4) = 133 Mb/sec

- Using the results in Table 16-11 and equation 7, the DMA throughput for this memory transfer is calculated to be 109.3 Mb/sec.

  DMA_PCI_Through_Put = (Transfer_size x pci _clk x clk_ratio) / cyc_DMA_busy

  DMA_PCI_Through_Put = (4096 x 33MHz x 3) / (3709) = 109.3 Mb/sec

Table 16-11. DMA Channel Busy Example

Performance Monitor Register	Init Programming	End Result
CMDR0	0x0000_808c	—
PMC0	0x0000_0000	0x0000_0e7d (=3709)
MMCR	0x0000_0080	—

16.4.4.2 DMA Segment Busy

The performance monitor can sample an individual segment in a descriptor chain. For example, determine how much time is spent on the second segment and the entire chain. Table 16-12 shows the performance monitor settings for this example.

- Set up the DMA to transfer three separate blocks of data from PCI to local memory. The block sizes are as follows: segment1 = 32768 (0x8000), segment2 = 1024 (0x400), and segment3 = 4096 (0x1000).
- Set up PMC0 to measure the number of cycles a DMA channel is busy that is a type 1 event 140 (0x8c).
- Set up PMC1 for a type 1 event 144 (0x90) that counts the number of cycles that elapsed since segment2 began. Select the segment by setting the threshold to two in PMC1. Note that only PMC0 and PMC1 can use thresholds.

Analyzing the end results in Table 16-12 shows that three percent of the time was spent on segment two and the overall DMA throughput was 126.3 Mbytes/sec. This transfer was able to utilize 95 percent of the total PCI bandwidth.

DMA_segment_2 = (1024 x 33 x 3) / 974 = 104.8 Mb/sec

DMA_PCI_through_put = ((32768+1024+4096) x 33 x 3) / 29695 = 126.3Mb/sec

Percent_of_total_PCI_bandwidth = (126.3Mb/sec) / (133 Mb/sec) = 95 percent

Table 16-12. DMA Segment Busy Example

Performance Monitor Register	Init Programming	End Result
CMDR0	0x0000_808c	—
CMDR1	0x0000_2090	—

Table 16-12. DMA Segment Busy Example (continued)

Performance Monitor Register	Init Programming	End Result
PMC0	0x0000_0000	0x0000_73ff (=29695)
PMC1	0x0000_0000	0x0000__03ce (=974)
MMCR	0x0000_0080	—

Chapter 17
Debug Features

The MPC8245 provides the following features to aid system bring-up and debugging:

- Address attributes signals identify the source and type of transaction that is currently being performed on either the PCI or memory interface.
- The debug address signal supplements the SDRAM column address and chip-select signals, allowing the system to reconstruct the corresponding physical address on the internal peripheral logic bus in a single cycle.
- The $\overline{\text{MIV}}$ signal marks valid address and data bus cycles on the memory bus.
- The memory data-path error injection/capture injects multi-bit stuck-at faults onto the peripheral logic or memory data/parity buses and captures data/parity on receipt of an ECC or parity error.
- JTAG/testing support is included.

17.1 Debug Register Summary

The MPC8245 contains six memory data-path diagnostic debug registers, including three error injection mask registers and three error capture monitor registers. The registers are mapped as follows:

- Embedded utilities memory block (EUMBBAR) for local bus accesses at offsets 0xF_F000 to 0xF_FFFF
- Embedded utilities peripheral control and status registers (PCSRBAR) for PCI bus accesses at offsets 0xF00 to 0xFFF

Note that this data-path diagnostic register space is also shared with the watchpoint registers described in Chapter 18, “Programmable I/O and Watchpoint.” These offsets to individual registers are defined in Table 17-1. The memory data-path error injection/capture functionality is described in more detail in Section 17.5, “Memory Datapath Error Injection/Capture.” Note that although these registers are mapped from local bus offset 0xF_F000 to0xF_F014 (PCI offset 0xF00 to 0xF14), the watchpoint registers are mapped from the local bus offset 0xF_F018 though 0xF_F042 (PCI offset 0xF18 to 0xF42).

Table 17-1. Memory Data-Path Diagnostic Register Offsets

Local Bus Offset	PCI Bus Offset	Size (bytes)	Program Access Size (bytes)	Register	Register Access	Reset Value
0xF_F000	0xF00	4	4	Data High Error Injection Mask	R/W	0x0000_0000
0xF_F004	0xF04	4	4	Data Low Error Injection Mask	R/W	0x0000_0000
0xF_F008	0xF08	4	1, 2, or 4	Parity Error Injection Mask Register	R/W	0x0000_0000
0xF_F00C	0xF0C	4	4	Data High Error Capture Monitor Register	R	0x0000_0000
0xF_F010	0xF10	4	4	Data Low Error Capture Monitor Register	R	0x0000_0000
0xF_F014	0xF14	4	1, 2, or 4	Parity High Error Capture Monitor Register	R/W	0x0000_0000

17.2 Address Attribute Signals

The MPC8245 provides additional information that corresponds to memory and PCI activity on several signals to assist with system debug. These signals are the memory attribute signals (MAA[0:2]) and the PCI attribute signals (PMAA[0:2]), as summarized in Table 17-2.

Table 17-2. Address Attribute Signal Summary

Signal Name	Pins	I/O	Signal Meaning
MAA[0:2]	3	O	Memory address attributes
PMAA[0:2]	3	O	PCI address attributes

17.2.1 Memory Address Attribute Signals (MAA[0:2])

The memory attribute signals are associated with the memory interface and provide information about the source of the memory operation that the MPC8245 is performing.

Table 17-3 shows encodings of the memory address attribute signal.

Table 17-3. Memory Address Attribute Signal Encodings

MAA0	MAA1	MAA2	Memory Operation	Definition
0	0	0	Read	Processor data read
0	0	1	Read	Processor touch load
0	1	0	Read	Processor instruction fetch
0	1	1	—	Reserved

Table 17-3. Memory Address Attribute Signal Encodings (continued)

MAA0	MAA1	MAA2	Memory Operation	Definition
1	0	0	Read	PCI memory read
1	0	1	Read	DMA channel 0 memory read
1	1	0	Read	DMA channel 1 memory read
1	1	1	Read	I2O memory read
0	0	0	Write	Processor data write
0	0	1	—	Reserved
0	1	0	—	Reserved
0	1	1	—	Reserved
1	0	0	Write	PCI memory write
1	0	1	Write	DMA channel 0 memory write
1	1	0	Write	DMA channel 1 memory write
1	1	1	Read	I2O memory write

17.2.2 Memory Address Attribute Signal Timing

Timing characteristics for memory address attribute signals are shown in Figure 17-3 through Figure 17-13. These figures also show the relationship of MAA[0:2] to the $\overline{\text{MIV}}$ signal. Note that the attribute signals are valid at the same time as the column address for all SDRAM accesses, including single-beat, burst, 32- and 64-bit modes, page misses, page hits, and others. Note that for all ROM/Flash accesses, the attribute signals are valid when the address is valid.

17.2.3 PCI Address Attribute Signals

PCI address attribute signals provide information about the source of the PCI operation that the MPC8240 performs. Table 17-4 shows their encodings.

Table 17-4. PCI Attribute Signal Encodings

PMAA0	PMAA1	PMAA2	PCI Operation	Definition
0	0	0	Read	Processor data load
0	0	1	Read	Processor touch load
0	1	0	Read	Processor instruction fetch

Table 17-4. PCI Attribute Signal Encodings (continued)

PMAA0	PMAA1	PMAA2	PCI Operation	Definition
0	1	1	—	Reserved
1	0	0	—	Reserved
1	0	1	Read	DMA channel 0 PCI read
1	1	0	Read	DMA channel 1 PCI read
1	1	1	Read	PCI address bus invalid
0	0	0	Write	Processor data write
0	0	1	—	Reserved
0	1	0	—	Reserved
0	1	1	—	Reserved
1	0	0	—	Reserved
1	0	1	Write	DMA channel 0 PCI write
1	1	0	Write	DMA channel 1 PCI write
1	1	1	Write	PCI address bus invalid

17.2.4 PCI Address Attribute Signal Timing

Timing characteristics for PCI attribute signals are shown in Figure 17-1 and Figure 17-2. The attribute signals are valid at the same time as the address for all MPC8240-sourced PCI accesses. During all other clock cycles, PMAA[0:2] are held at the value 0b111.

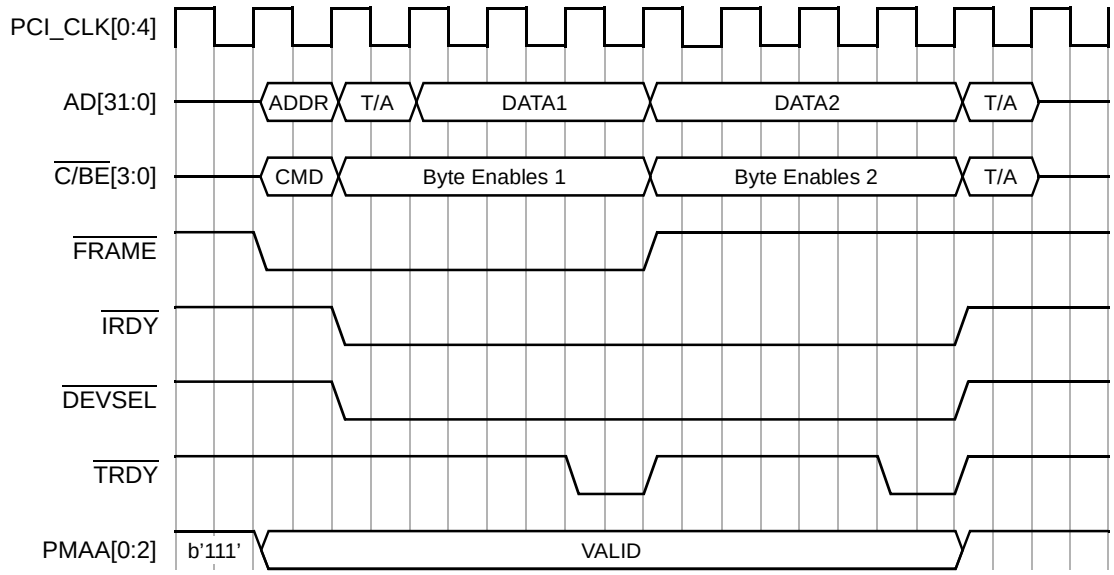


Figure 17-1. Example PCI Address Attribute Signal Timing for Burst Read Operations

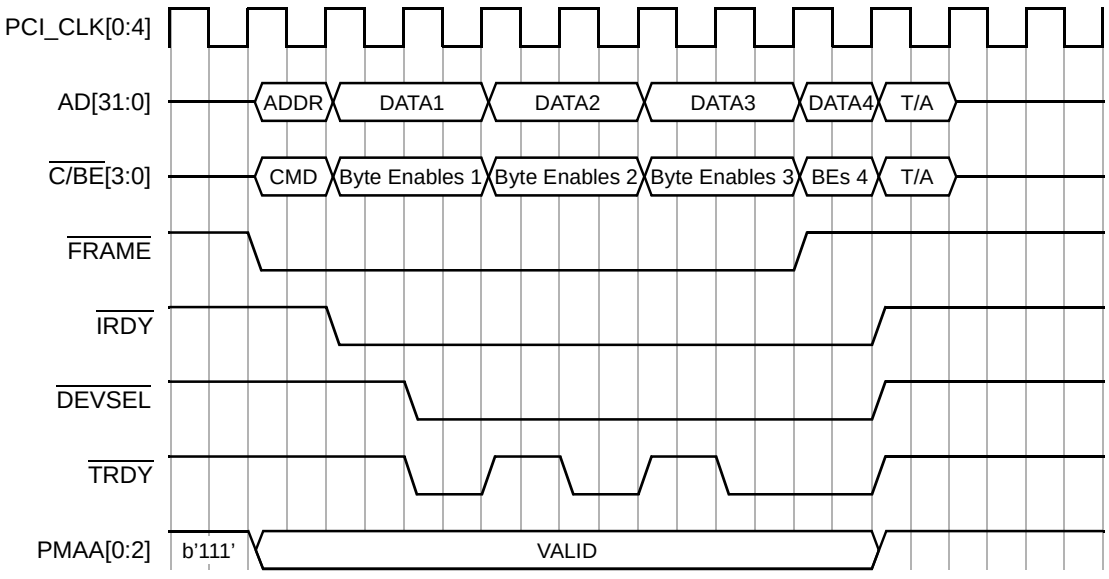


Figure 17-2. Example PCI Address Attribute Signal Timing for Burst Write Operations

17.3 Memory Debug Address

When enabled, the debug address gives software disassemblers a simple way to reconstruct the 31-bit physical address for a memory bus transaction to SDRAM, ROM, Flash, or Port X. For SDRAMs, these 16 debug address signals are sampled with the column address and chip-selects. For ROM, Flash, and Port X devices, the debug address pins are sampled at the same time as the ROM address and can be used to recreate the 24-bit physical address with ROM address. The granularity of the reconstructed physical address is limited by the bus width of the interface: double words for 64-bit interfaces, words for 32-bit interfaces, and bytes for 8-bit interfaces.

17.3.1 Enabling Debug Address

Using the $\overline{\text{GNT4}}$ reset configuration signal enables or disables debug address functionality at reset. If the $\overline{\text{GNT4}}$ signal is left floating at reset, an internal pull-up forces it high, disabling the debug address functionality. If $\overline{\text{GNT4}}$ is asserted at reset (driven low), the debug address functionality is enabled.

Furthermore, software can write the DEBUG_ADDR bit in the watchpoint monitor's control register, WPM_CONTROL, to enabled or disable debug address functionality. However, its functionality is not directly related to WPM, and is intended for use during debug as a convenient logic analyzer trigger point.

DEBUG_ADDR is an active low control; 1= debug address is disabled, 0= debug address is enabled.

17.3.2 Debug Address Signal Definitions

Table 17-5 shows the mapping of all the memory debug address signals and their alternate functions. Note that while the signals are all outputs when used as the debug address signals, some of these signals are defined as inputs for the alternate functions.

Table 17-5. Memory Debug Address Signal Definitions

Signal	Signal Meaning	Alternate Function	Pins	I/O
DA[15–11]	debug_address [15–11]	—	5	O
DA[10–6]	debug_address [10–6]	PLL_CFG[0–4]	5	O
DA5	debug_address 5	GNT4	1	O
DA4	debug_address 4	REQ4	1	O
DA3	debug_address 3	PCI_CLK4	1	O
DA2	debug_address 2	—	1	O
DA1	debug_address 1	CKO	1	O

Table 17-5. Memory Debug Address Signal Definitions (continued)

Signal	Signal Meaning	Alternate Function	Pins	I/O
DA0	debug_address 0	QACK	1	O
GNT4	Debug address enable (during reset configuration). 0 Debug address enabled; partial address of the transaction driven on DA[15-0]. 1 Debug address disabled	GNT4; DA5	1	I

17.3.3 Physical Address Mappings

Figure 17-3 and Figure 17-4 show the physical address mappings for 64- and 32-bit SDRAM. The physical address mappings for 64-, 32-,16-, and 8-bit ROM/Flash are depicted in Figure 17-5, Figure 17-6, Figure 17-7, and Figure 17-8, respectively. The encoded version of $\overline{CS}$[0:7] shown in the figures is described in Section 17.3.4, “CS Encoding.”

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	N[1]	SDMA[14:12]			debug_address[0:15]																SDMA[7:0]								-	-	-

Note 1: The value of physical address bit 30 is based on an encoding of $\overline{CS}$[0:7] and the assumption that individual chip-selects may not straddle the 1 to 2G boundary, such that:

1) If physical address bit 30 = 0, the lower Gig of SDRAM address space 0–(1G-1) is selected.

2) If physical address bit 30 = 1, the upper Gig of SDRAM address space 1G–(2G-1) is selected.

Figure 17-3. 64-Bit SDRAM Physical Address for Debug

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	N[1]	SDMA[14:12]			debug_address[0:15]																SDMA[8:0]										-	-

Note 1: The value of physical address bit 30 is based on an encoding of $\overline{CS}$[0:7] and the assumption that individual chip-selects may not straddle the 1 to 2G boundary, such that:

1) If physical address bit 30 = 0, the lower Gig of SDRAM address space 0–(1G-1) is selected.

2) If physical address bit 30 = 1, the upper Gig of SDRAM address space 1G–(2G-1) is selected.

Figure 17-4. 32-Bit SDRAM Physical Address for Debug

$\overline{RCS}$	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[0:1]	1	1	1	1	1	1	1	1	debug_address[3:15]													SDMA[7:0]									-	-
[2:3]	0	1	1	1	N[1]	debug_address[0:15]																SDMA[7:0] of address								-	-	-

Note 1: Value of physical address bit 27 based on chip-select. Section 17.3.5, “Extended ROM Chip Select Encoding.”

Figure 17-5. 64-Bit ROM/Flash Physical Address for Debug

$\overline{RCS}$	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[0:1]	1	1	1	1	1	1	1	1	debug_address[3:15]													SDMA[8:0]									-	-
[2:3]	0	1	1	1	N[1]	debug_address[0:15]																SDMA[8:0]									-	-

Note 1: Value of physical address bit 27 based on chip-select. Section 17.3.5, “Extended ROM Chip Select Encoding.”

Figure 17-6. 32-Bit ROM/Flash Physical Address for Debug

$\overline{RCS}$	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[0:1]	NA																															
[2:3]	0	1	1	1	N[1]	debug_address[0:15]																SDMA[9:0]										-

Note 1: Value of physical address bit 27 based on chip-select. Section 17.3.5, “Extended ROM Chip Select Encoding.”

Figure 17-7. 16-Bit ROM/Flash Physical Address for Debug

$\overline{RCS}$	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[0:1]	1	1	1	1	1	1	1	1	debug_address[3:15]													SDMA[10:0]										
[2:3]	0	1	1	1	N[1]	debug_address[0:15]																SDMA[10:0]										

Note 1: Value of physical address bit 27 based on chip-select. Section 17.3.5, “Extended ROM Chip Select Encoding.”

Figure 17-8. 8-Bit ROM/Flash Physical Address for Debug

17.3.4 $\overline{CS}$ Encoding

Encoding $\overline{CS}$[0:7] to form bits 29–27 of the physical address for SDRAM transactions is based on the memory bank configuration that is programmed in the bank starting and ending address configuration registers located at offsets 0x80, 0x84, 0x88, 0x8C, 0x90, 0x94, 0x98, and 0x9C. To make this encoding algorithm deterministic, SDRAM banks are not allowed to cross a 128-Mbyte address partition (that is, the starting and ending address for any one bank must fall within the same 128-Mbyte partition). Obviously, such $\overline{CS}$ information is relevant only for SDRAM and not for ROM/Flash. For a simple example of $\overline{CS}$ encodings, see Table 17-6.

Table 17-6. Example of $\overline{CS}$ Encoding for 568-Mbyte Memory System

Partition	Encoded $\overline{CS}$: Physical Address[29:27]	Address		Bank	Bank Size	$\overline{CS}$[0:7]
Eighth 128MEG partition of 1GIG Main Memory	0b111	Ending	0x3FF	Undefined		
		Starting	0x380			
Seventh 128MEG partition of 1GIG Main Memory	0b110	Ending	0x37F	Undefined		
		Starting	0x300			
Sixth 128MEG partition of 1GIG Main Memory	0b101	Ending	0x2FF	Undefined		
		Starting	0x280			
Fifth 128MEG partition of 1GIG Main Memory	0b100	Ending	0x27F	Undefined		
		Starting	0x238			
		Ending	0x237	7	8MB	0xFE
		Starting	0x230			
		Ending	0x22F	6	16MB	0xFD
		Starting	0x220			
		Ending	0x21F	5	32MB	0xFB
		Starting	0x200			
Fourth 128MEG partition of 1GIG Main Memory	0b011	Ending	0x1FF	4	64MB	0xF7
		Starting	0x1C0			
		Ending	0x1BF	3	64MB	0xEF
		Starting	0x180			
Third 128MEG partition of 1GIG Main Memory	0b010	Ending	0x17F	1	128MB	0xBF
		Starting	0x100			
Second 128MEG partition of 1GIG Main Memory	0b001	Ending	0x0FF	2	128MB	0xDF
		Starting	0x080			
First 128MEG partition of 1GIG Main Memory	0b000	Ending	0x07F	0	128MB	0x7F
		Starting	0x000			

17.3.5 Extended ROM Chip Select Encoding

To ensure that software can decode the 27th bit of the physical address for extended ROM accesses, firmware must program the starting and ending addresses ranges for $\overline{RCS2}$ or $\overline{RCS3}$ such that neither straddles addresses 0x77FF_FFFF through 0x7800_0000. If this guideline is obeyed, the 27th bit of the physical address can be inferred from the chip-select and its corresponding starting and ending addresses.

- If the starting and ending address for $\overline{\text{RCS}n}$ are both <= 0x77FF_FFFF, the 27th physical address bit for this chip-select is always 0.
- If the starting and ending address for $\overline{\text{RCS}n}$ are both >= 0x7800_0000, the 27th physical address bit for this chip-select is always 1.

17.3.6 Debug Address Timing

For examples of debug address timing for various memory types, see Figure 17-3 through Figure 17-13.

17.4 Memory Interface Valid ($\overline{\text{MIV}}$)

The memory interface valid signal $\overline{\text{MIV}}$ is asserted whenever SDRAM, Flash, or ROM addresses or data are present on the external memory bus. The signal helps reduce the number of bus cycles that logic analyzers must store in memory during a debug trace (see Table 17-7). The $\overline{\text{MIV}}$ signal should be sampled with the rising edge of SDRAM_CLK[0:3].

Table 17-7. Memory Interface Valid Signal Definition

Signal Name	Pins	Active	I/O	Signal Meaning
MIV	1	Low	O	Indicates that the transaction address or data is valid on the memory bus.

17.4.1 $\overline{\text{MIV}}$ Signal Timing

The $\overline{\text{MIV}}$ signal is an active low signal and has timing characteristics that Figure 17-9 through Figure 17-13 show.

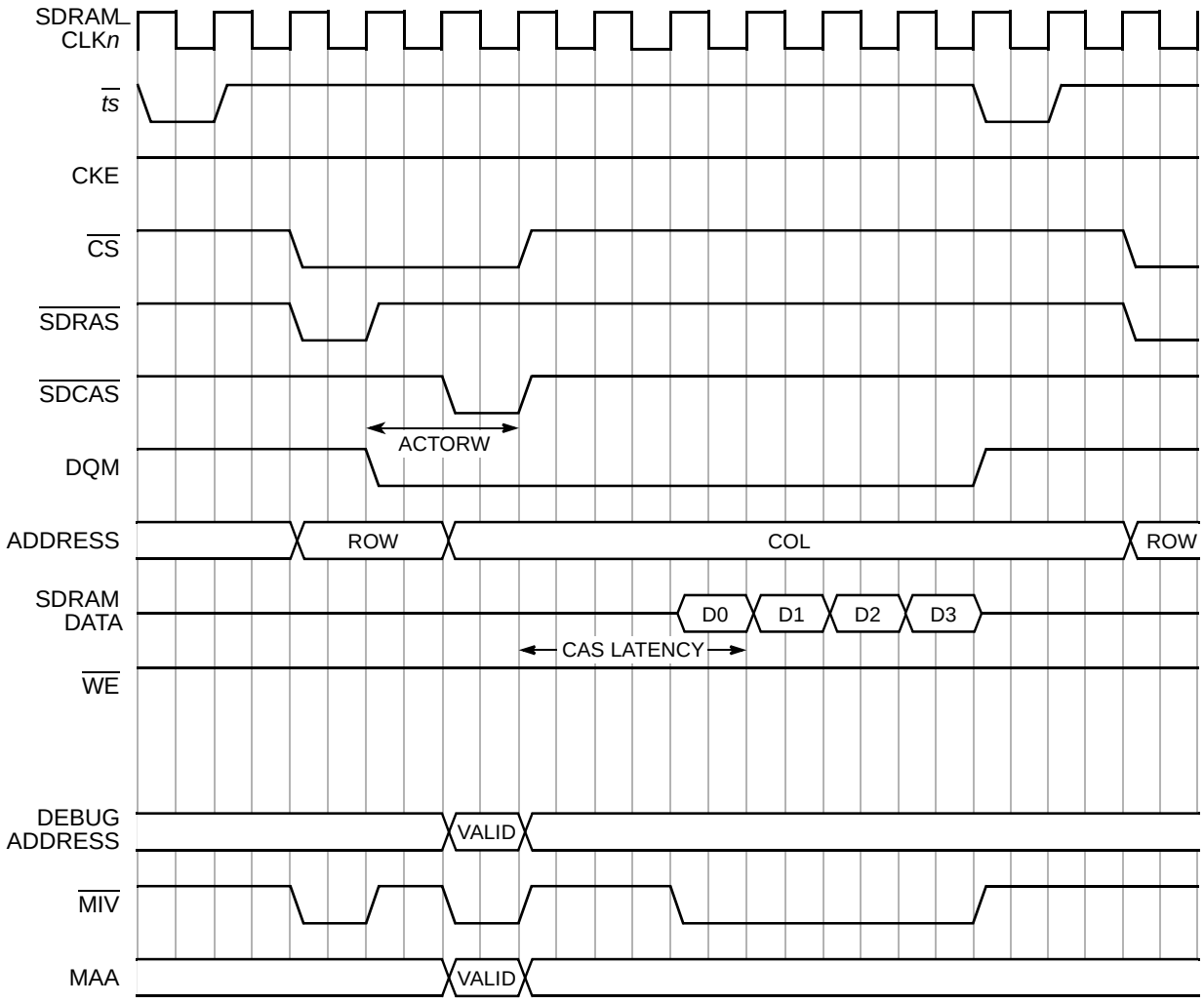


Figure 17-9. SDRAM Debug Address, $\overline{\text{MIV}}$, and MAA Timings for Burst Read Operation

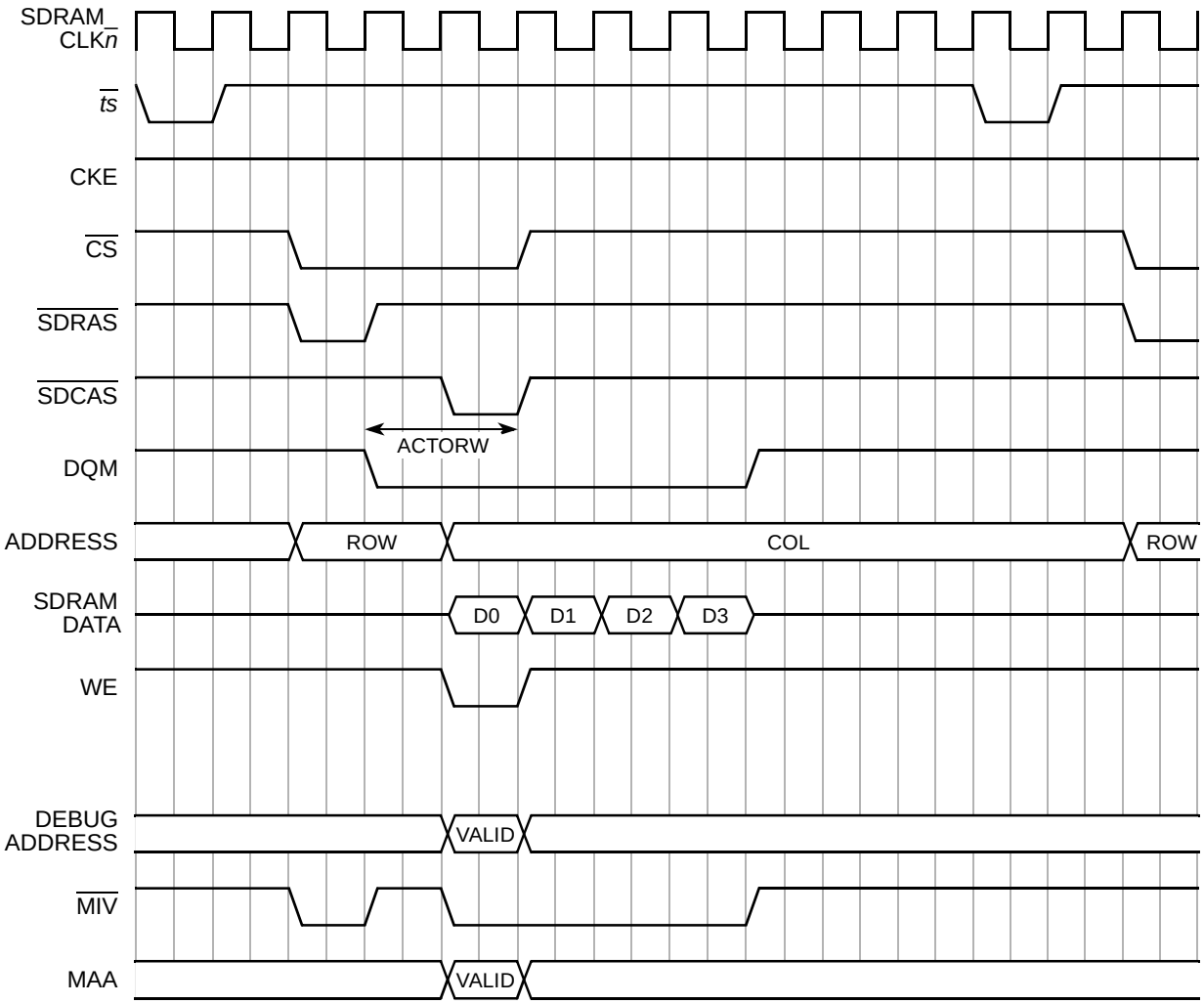
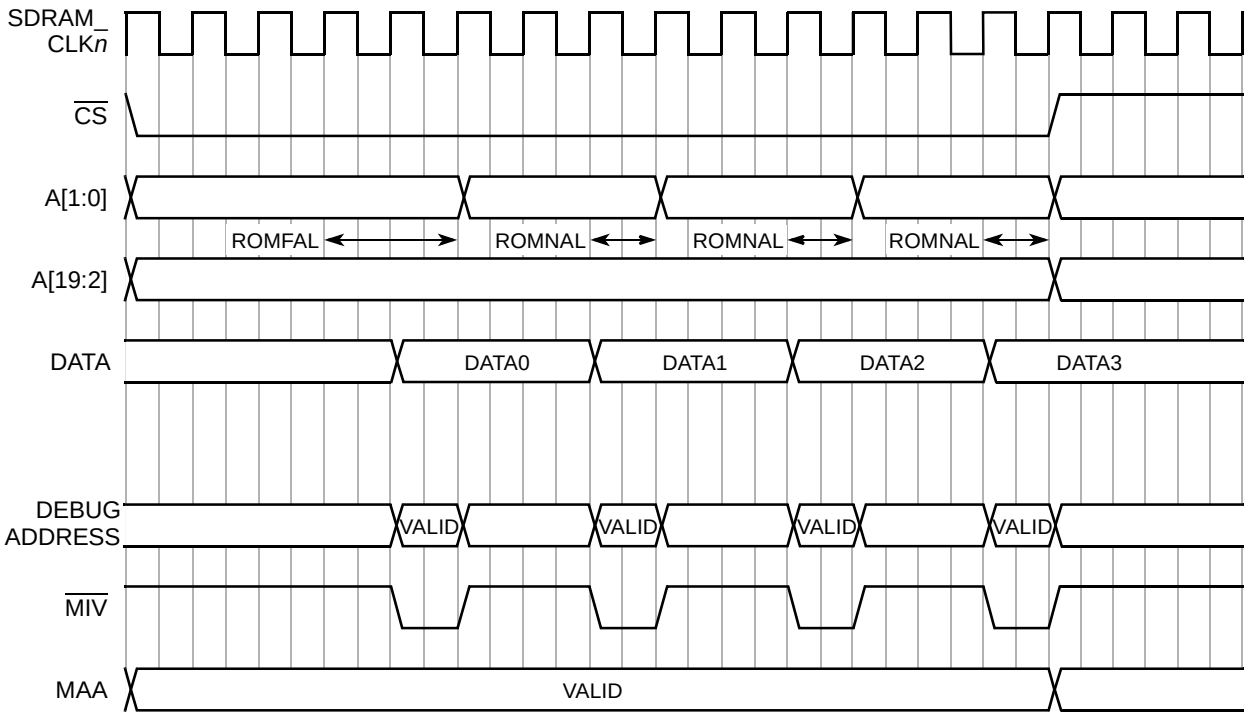


Figure 17-10. SDRAM Debug Address, MIV, and MAA Timings for Burst Write Operation



NOTES:
1. ROMFAL = 0–31 clocks
2. ROMNAL = 0–15 clocks
3. Memory configuration BURST = 1

Figure 17-11. Example ROM Debug Address, $\overline{\text{MIV}}$, and MAA Timings For Burst Read

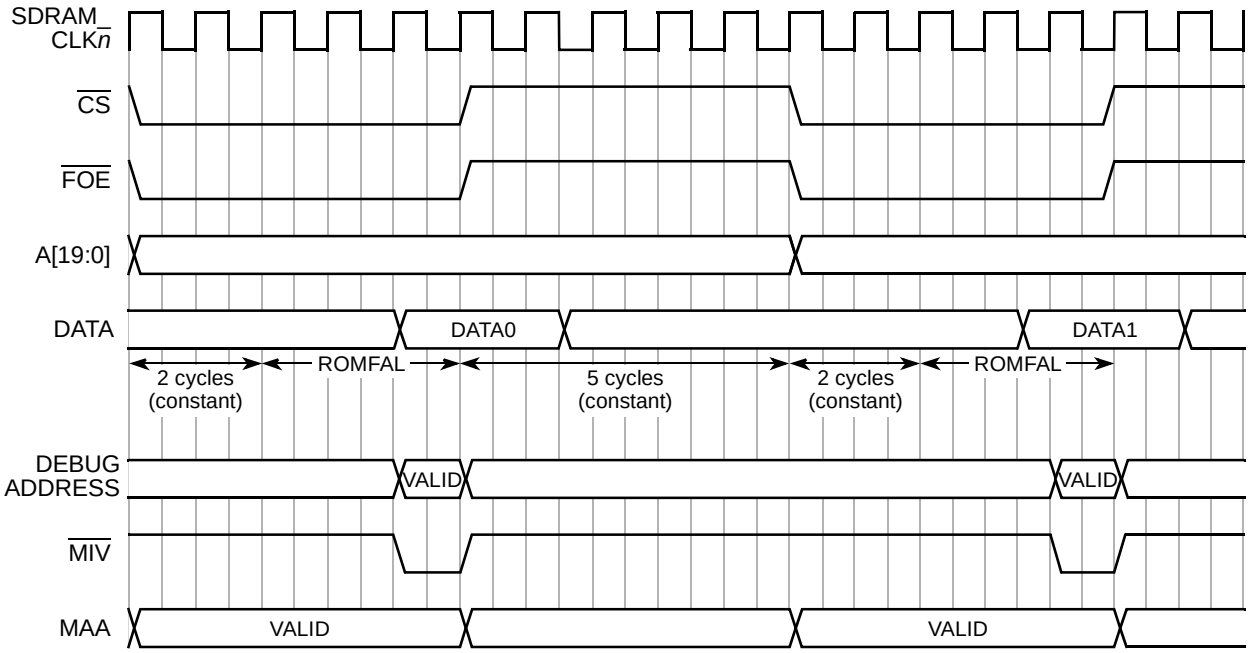


Figure 17-12. Example Flash Debug Address, MIV, and MAA Timings For Single-Byte Read

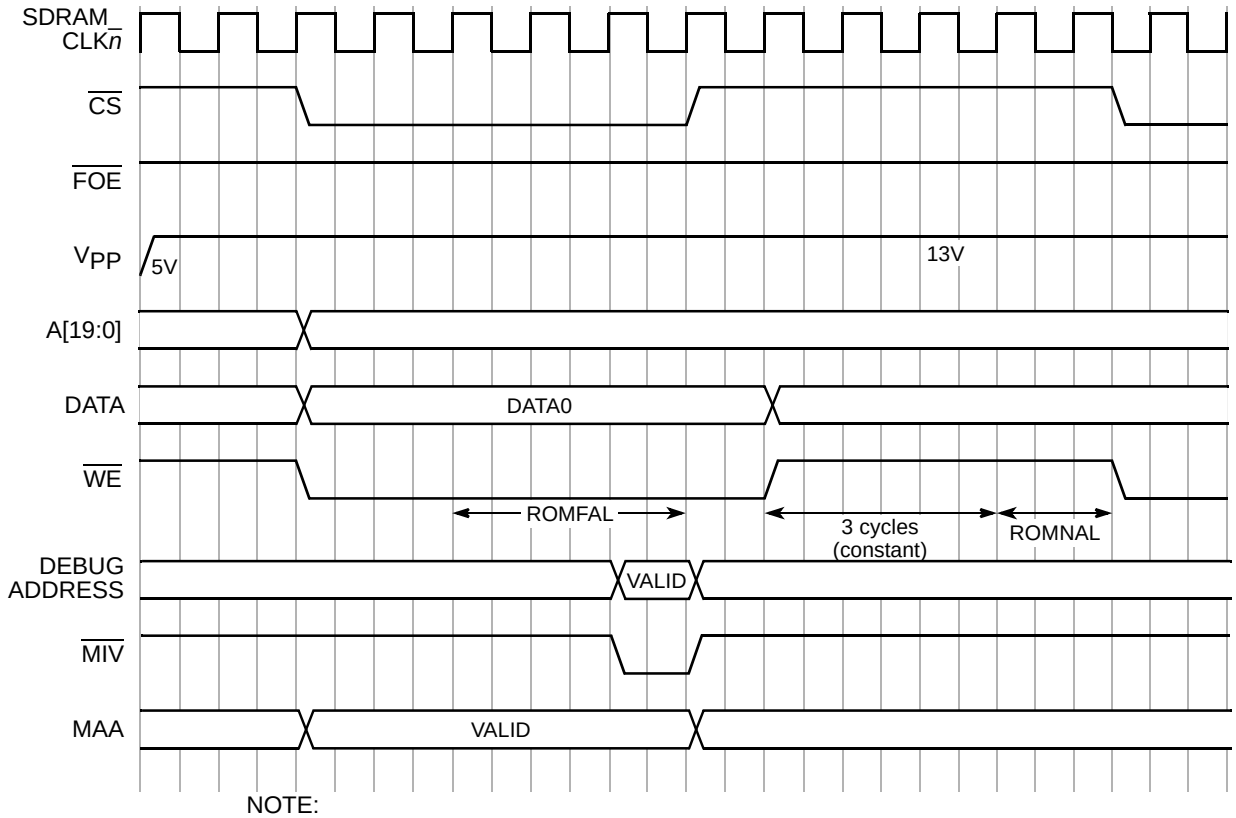


Figure 17-13. Example Flash Debug Address, $\overline{\text{MIV}}$, and MAA Timings for Write Operation

17.5 Memory Datapath Error Injection/Capture

The MPC8245 provides hardware to exercise and debug the on-chip ECC and parity logic. allowing injection of multi-bit stuck-at faults onto the peripheral logic or memory data/parity buses and capture the data/parity on receipt of an ECC or parity error.

The memory data-path error injection/capture system is programmed using the six memory data-path diagnostic registers and the WP_CONTROL register. These registers allow the user to program error injection masks and to monitor ECC/parity error capture data. The memory data-path diagnostic registers are accessible from either the local bus or PCI port.

NOTE

WP_CONTROL[WP_DATC] must equal 0b10 to enable memory data path error injection/capture. All memory data-path diagnostic registers are reset to zero, 0x0000_0000, unless otherwise specified.

17.5.1 Memory Data-Path Error Injection Mask Registers

The memory data-path error injection masks inject errors onto the internal peripheral logic bus or the memory data/parity buses, as Figure 17-14 shows. Separate mask registers are provided for the high data, low data, and parity buses. The masks are bit-wise inverting; a 0b1 in the mask causes the corresponding bit on the data/parity bus to be inverted. Read and write mask enable bits apply the masks to the read or write data-path. These registers can be read or written and are initialized to 0x0000_0000.

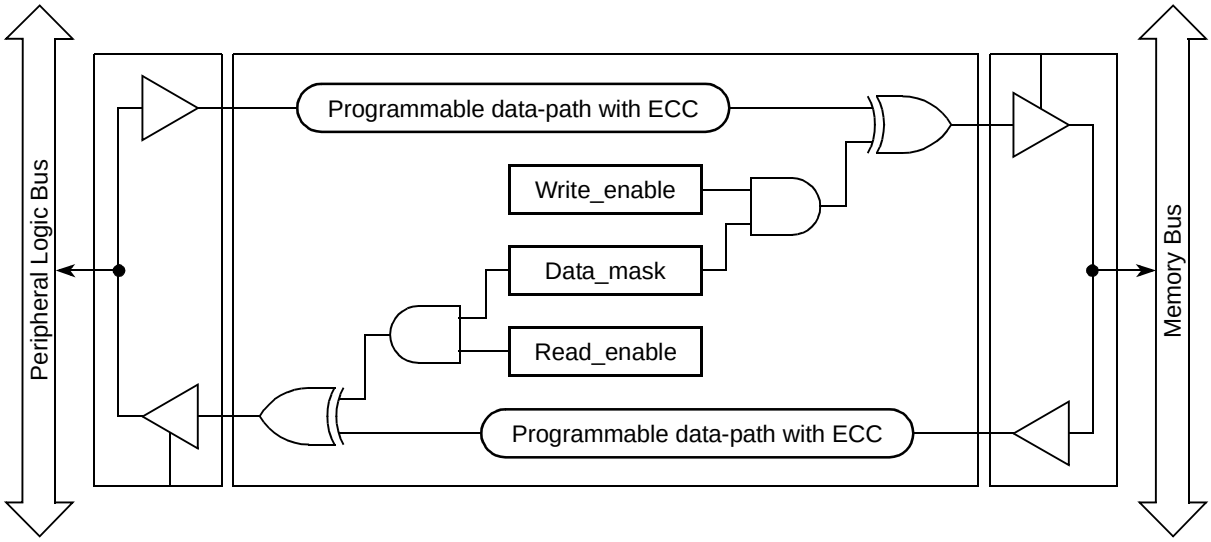


Figure 17-14. Functional Diagram of Memory Data-Path Error Injection

17.5.1.1 Data High Error Injection Mask Register

Figure 17-15 shows the bits of the data high error injection mask register.

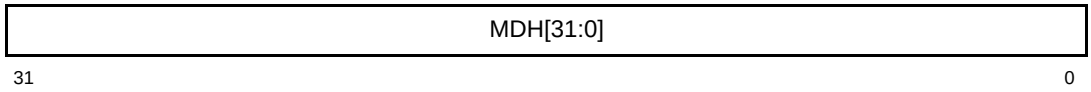


Figure 17-15. Data High Error Injection Mask—Offsets 0xF_F000, 0xF00

Table 17-8 shows the bit definitions of the data high error injection mask register.

Table 17-8. Data High Error Injection Mask Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–0	MDH[31:0]	All 0s	R/W	Error injection mask for memory data-path data bus high

17.5.1.2 Data Low Error Injection Mask Register

Figure 17-16 shows the bits of the data low error injection mask register.

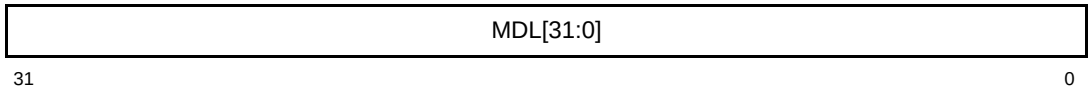


Figure 17-16. Data Low Error Injection Mask—Offsets 0xF_F004, 0xF04

Table 17-9 shows the bit definitions of the data low error injection mask register.

Table 17-9. Data Low Error Injection Mask Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–0	MDL[31:0]	All 0s	R/W	Error injection mask for memory data-path data bus low

17.5.1.3 Parity Error Injection Mask Register

Figure 17-17 shows the bits of the data high error injection mask register and Table 17-10 shows the bit definitions.

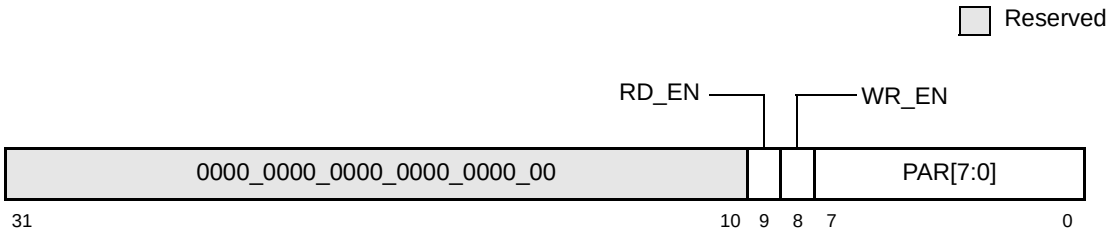


Figure 17-17. Parity Error Injection Mask—Offsets 0xF_F008, 0xF08

Table 17-10. Parity Error Injection Mask Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–8	—	All 0s	Read	Reserved
9	RD_EN	0	R/W	Memory data-path read enable bit 0 Disables error injection for reads. 1 Enables error injection onto the peripheral logic data bus during reads from local memory.
8	WR_EN	0	R/W	Memory data-path write enable bit 0 Disables error injection for writes. 1 Enables error injection onto the memory data bus during writes to local memory.
7–0	PAR[7:0]	0b0000_0000	R/W	Error injection mask for memory data parity bus.

17.5.2 Memory Data-Path Error Capture Monitor Registers

The memory data-path error capture monitors latch data that causes ECC or parity errors from either the internal peripheral logic bus or the memory data/parity bus. Separate monitors are provided for the high data, low data, and parity buses. The monitors are read-only. They are loaded automatically when the error detection registers detect any of the following:

- A memory read parity error / single-bit ECC error trigger exceeded; EDR1[2].
- A multi-bit ECC error; EDR2[3].
- A write parity error; EDR2[2].

When memory data-path parity/ECC error data is loaded into the monitors, the capture flag in the parity error capture monitor register, at offsets 0xF_F014, and 0xF14, is also set. This control bit is sticky and remains set until explicitly cleared by the software. The set capture flag prevents subsequent errors from overwriting the data from the first failure. The capture flag is the only bit in the memory data-path error capture monitors that is read/write.

17.5.2.1 Data High Error Capture Monitor Register

Figure 17-18 shows the bits of the data high error capture monitor register.

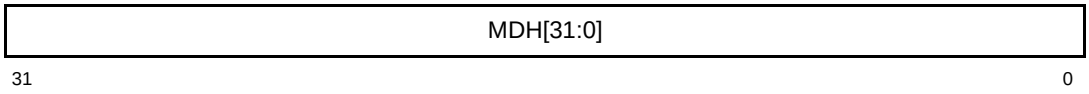


Figure 17-18. Data High Error Capture Monitor—Offsets 0xF_F00C, 0xF0C

Table 17-11 shows the bit definitions of the data high error capture monitor register.

Table 17-11. Data High Error Capture Monitor Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–0	MDH[31:0]	All 0s	Read	Capture monitor for memory data-path data bus high

17.5.2.2 Data Low Error Capture Monitor Register

Figure 17-19 shows the bits of the data low error capture monitor register.

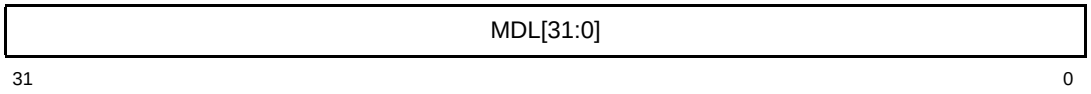


Figure 17-19. Data Low Error Capture Monitor—Offsets 0xF_F010, 0xF10

Table 17-12 shows the bit definitions of the data low error capture monitor register.

Table 17-12. Data Low Error Capture Monitor Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–0	MDL[31:0]	All 0s	Read	Capture monitor for memory data-path data bus low

17.5.2.3 Parity Error Capture Monitor Register

Figure 17-20 shows the bits of the parity error capture monitor register and Table 17-13 shows the bit definitions.

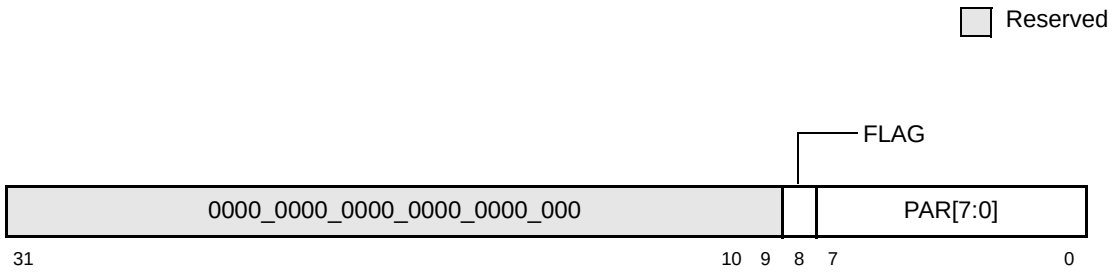


Figure 17-20. Parity Error Capture Monitor—Offsets 0xF_F014, 0xF14

Table 17-13. Parity High Error Capture Monitor Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–9	—	All 0s	Read	reserved
8	FLAG	0	R/W	Capture flag 0 No data captured 1 Data valid
7–0	PAR[7:0]	0b0000_0000	Read	Capture monitor for memory data-path data parity bus.

17.6 JTAG/Testing Support

The MPC8245 provides a joint test action group (JTAG) interface to facilitate boundary-scan testing. The JTAG interface complies to the IEEE 1149.1 boundary-scan specification. For additional information about JTAG operations, refer to the IEEE 1149.1 specification.

The JTAG interface consists of a set of five signals, three JTAG registers, and a test access port (TAP) controller, described in the following sections. A block diagram of the JTAG interface is shown in Figure 17-21.

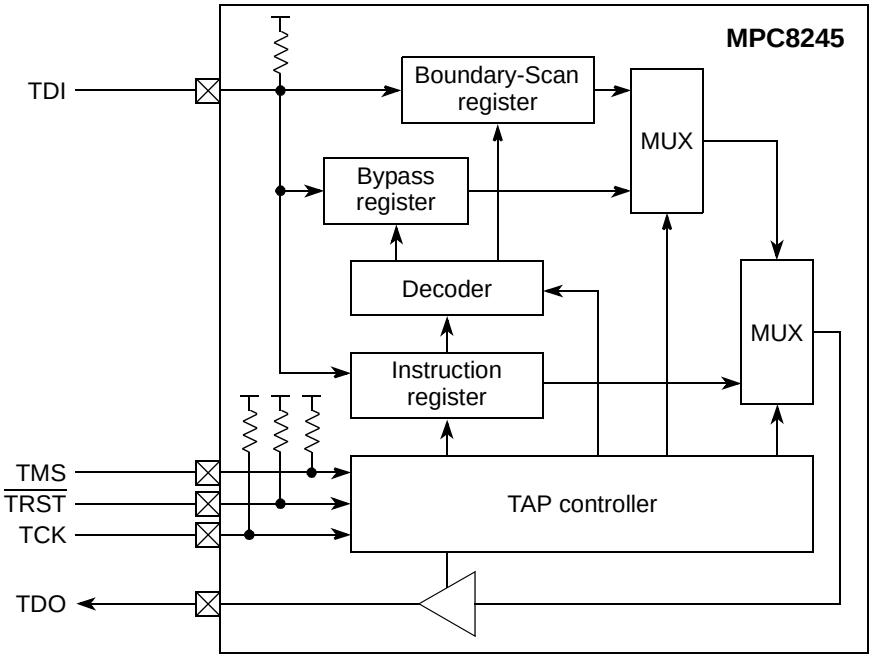


Figure 17-21. JTAG Interface Block Diagram

17.6.1 JTAG Signals

The MPC8245 provides five dedicated JTAG signals—test data input (TDI), test mode select (TMS), test reset ($\overline{\text{TRST}}$), test clock (TCK), and test data output (TDO). The TDI and TDO signals input and output instructions and data to the JTAG scan registers. The boundary-scan operations are controlled by the TAP controller through commands received by means of the TMS signal. Boundary-scan data is latched by the TAP controller on the rising edge of the TCK signal. The $\overline{\text{TRST}}$ signal is specified as optional by the IEEE 1149.1 specification, and is used to reset the TAP controller asynchronously. The assertion of the $\overline{\text{TRST}}$ signal at power-on reset ensures that the JTAG logic does not interfere with the normal operation of the MPC8245.

Section 2.2.7, “Test and Configuration Signals,” provides more detailed information about the JTAG signals.

17.6.2 JTAG Registers and Scan Chains

The bypass, boundary-scan, and instruction JTAG registers and their associated scan chains are implemented by the MPC8245. These registers are mandatory for compliance with the IEEE 1149.1 specification.

17.6.2.1 Bypass Register

The bypass register is a single-stage register used to bypass the boundary-scan latches of the MPC8245 during board-level boundary-scan operations involving components other than the MPC8245. The use of the bypass register reduces the total scan string size of the boundary-scan test.

17.6.2.2 Boundary-Scan Registers

The JTAG interface provides a chain of registers dedicated to boundary-scan operations. To be JTAG-compliant, these registers cannot be shared with any functional registers of the MPC8245. The boundary-scan register chain includes registers controlling the direction of the input/output drivers, in addition to the registers reflecting the signal value received or driven.

The boundary-scan registers capture the input or output state of the MPC8245's signals during a Capture_DR TAP controller state. When a data scan is initiated following the Capture_DR state, the sampled values are shifted out through the TDO output while new boundary-scan register values are shifted in through the TDI input. At the end of the data scan operation, the boundary-scan registers are updated with the new values during an Update_DR TAP controller state.

17.6.2.3 Instruction Register

The 8-bit JTAG instruction register serves as an instruction and status register. As TAP controller instructions are scanned in through the TDI input, the TAP controller status bits are scanned out through the TDO output.

17.6.2.4 TAP Controller

The MPC8245 provides a standard JTAG TAP controller that controls instruction and data scan operations. The TMS signal controls the state transitions of the TAP controller.

Chapter 18
Programmable I/O and Watchpoint

This chapter describes the capabilities of the TRIG_IN signal and how the TRIG_OUT signal can be generated based on programmable watchpoints on the internal processor bus.

18.1 Overview

The MPC8245 programmable I/O and watchpoint facility allows system designers to monitor the state of the internal peripheral logic (the interface between the processor core and the peripheral logic block) bus and trigger an output signal as shown in Figure 18-1. The user programs up to two sets of fully maskable 58-bit triggers called *watchpoints* on the peripheral logic address and control buses. When enabled, the watchpoint facility scans the peripheral logic bus for a user-programmable sequence of matches to these watchpoints. The peripheral logic bus signals are analogous to the 60x bus signals on the MPC603e. Throughout this chapter, they are referenced as the corresponding external signals in the *MPC603e RISC Microprocessor User's Manual*.

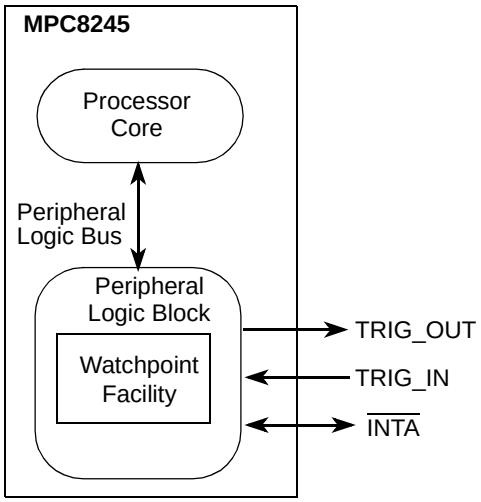


Figure 18-1. Watchpoint Facility Signal Interface

Each watchpoint has a dedicated, user programmable, 4-bit match count register. The value programmed into the count register determines the number of times the associated

watchpoint must match the state of the peripheral logic bus before the watchpoint facility generates a final match.

When a final watchpoint match is generated, the watchpoint facility latches the current status of the peripheral logic address and control buses into the associated watchpoint's dedicated, read-only, monitor registers. The watchpoint facility can also be configured to latch the peripheral logic data and data parity buses into a single set of read-only monitor registers upon either final watchpoint match.

Upon a final match, the watchpoint facility can be programmed to generate an external trigger pulse on the TRIG_OUT signal. Additionally, following the trigger pulse, the watchpoint facility can be programmed to disable itself and stop scanning (one-shot scan mode), or to continue to scan for the next occurrence of a final match (continuous scan mode) until explicitly disabled by the user. The watchpoint facility provides the following features:

- Two watchpoints with 58-bit triggers (signal-by-signal comparison on peripheral logic address and control bus) that control a single TRIG_OUT signal
- TRIG_IN signal for explicitly enabling and disabling the watchpoint facility and for exiting hold state
- A bit-wise programmable ANDing mask of a watchpoint trigger for each watchpoint
- The ability to trigger only on the *n*th watchpoint match where *n* is user-programmable for each watchpoint
- One-shot scan mode for generating only one trigger match and then automatically disabling the watchpoint facility
- Continuous scan mode that can be manually disabled for generating multiple trigger matches
- Single, waterfall, cascade, OR, and AND NOT modes that determine the interaction between watchpoints #1 and #2 (including their counter registers)

18.2 Watchpoint Interface Signal Description

The watchpoint facility uses the TRIG_IN and TRIG_OUT signals. TRIG_IN serves multiple functions as described in the WP_CONTROL[WP_RUN] bit description of Section 18.3.4, "Watchpoint Control Register (WP_CONTROL)." TRIG_OUT has many programmable attributes, See Table 18-7 of Section 18.3.4, "Watchpoint Control Register (WP_CONTROL)."

Table 18-1 summarizes information about the watchpoint facility.

Table 18-1. Watchpoint Signal Summary

Signal Name	Pins	Active	I/0	Signal Meaning	Timing Comments	Related WP_CONTROL Bits
TRIG_OUT	1	Active high or active low, depending on setting of WP_TRIG bit of WP_CONTROL	O	Indicates that the final watchpoint match occurred as defined in WP_MODE field of WP_CONTROL.	If WP_TRIG_HOLD = 0, single cycle pulse. If WP_TRIG_HOLD = 1, asserted until user toggles TRIG_IN.	WP_TRIG_HOLD WP_MODE WP_TRIG
TRIG_IN	1	HIGH	I	Rising edge: If the watchpoint facility is in the HOLD state (WP_TRIG_HOLD=1 and TRIG_OUT is active), a rising edge on this signal causes the device to exit the HOLD state, release TRIG_OUT, and resume normal operation. Otherwise, pulsing this signal toggles the value of the WP_RUN bit. Allows the user to turn the watchpoint facility on and off externally.	Single cycle pulse	WP_TRIG_HOLD WP_RUN

18.3 Watchpoint Registers

The watchpoint facility is programmed through the watchpoint registers, which allow programming of watchpoint triggers and masks, and reading results that watchpoint monitors store. Two sets of watchpoint triggers and masks and address and control registers are supported: watchpoint #1 and watchpoint #2. In addition, the watchpoint control register configures the debug address function of the MPC8245.

The watchpoint registers are accessible from either the local bus or the PCI bus. All watchpoint registers are reset to zero, 0x0000_0000, unless specified otherwise.

18.3.1 Watchpoint Register Address Map

The watchpoint registers reside in an area of the embedded utilities block that is shared by the memory data path diagnostic registers and are mapped as follows:

- Embedded utilities memory block (EUMBBAR contains base address) for local bus accesses. Watchpoint registers located at offsets 0xF_F000 to 0xF_FFFF.

- Embedded utilities peripheral control and status registers (PCSRBAR contains base address) for PCI bus accesses. Watchpoint registers are located at offsets 0xF00 to 0xFFF.

Table 18-2 shows offsets to individual watchpoint registers.

Table 18-2. Watchpoint Register Offsets

Local Bus Offset	PCI Bus Offset	Size (Bytes)	Program Access Size (Bytes)	Register	Register Access	Reset Value
0xFF00C	0xF0C	4	4	WP_DH_REG	Read Only	0x00000000
0xFF010	0xF10	4	4	WP_DL_REG	Read Only	0x00000000
0xFF014	0xF14	4	4	WP_PAR_REG	Read Only	0x00000000
0xFF018	0xF18	4	4	WP1_CNTL_TRIG	Read/Write	0x00000000
0xFF01C	0xF1C	4	4	WP1_ADDR_TRIG	Read/Write	0x00000000
0xFF020	0xF20	4	4	WP1_CTRL_MASK	Read/Write	0x00000000
0xFF024	0xF24	4	4	WP1_ADDR_MASK	Read/Write	0x00000000
0xFF028	0xF28	4	4	WP1_CTRL_MON	Read Only	0x00000000
0xFF02C	0xF2C	4	4	WP1_ADDR_MON	Read Only	0x00000000
0xFF030	0xF30	4	4	WP2_CNTL_TRIG	Read/Write	0x00000000
0xFF034	0xF34	4	4	WP2_ADDR_TRIG	Read/Write	0x00000000
0xFF038	0xF38	4	4	WP2_CTRL_MASK	Read/Write	0x00000000
0xFF03C	0xF3C	4	4	WP2_ADDR_MASK	Read/Write	0x00000000
0xFF040	0xF40	4	4	WP2_CTRL_MON	Read Only	0x00000000
0xFF044	0xF44	4	4	WP2_ADDR_MON	Read Only	0x00000000
0xFF048	0xF48	4	1, 2, or 4	WPM_CONTROL	Read/Write	0x10000000

18.3.2 Watchpoint Trigger Registers

Watchpoint triggers are set based on a subset of the peripheral logic bus that includes the 32-bit address bus and 26 control signals. These watchpoints are compared with the values on the peripheral logic bus on every clock cycle. Watchpoints #1 and #2 have separate sets of trigger registers, which are read/write and initialized to 0x0000_0000 on reset.

Figure 18-2 and Figure 18-3 show the format of the watchpoint #1 and watchpoint #2 control trigger registers (WP1_CNTL_TRIG and WP2_CNTL_TRIG). The format of these two registers is identical, but they are shown separately to emphasize that their locations are at different offsets.

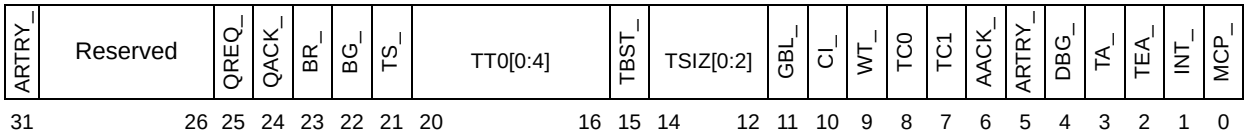


Figure 18-2. Watchpoint #1 Control Trigger Register (WP1_CNTL_TRIG)—Offsets 0xF_F018, 0xF18

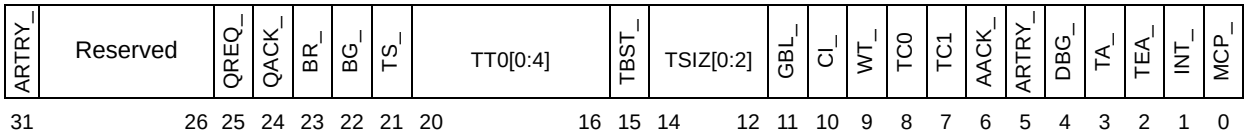


Figure 18-3. Watchpoint #2 Control Trigger Register (WP2_CNTL_TRIG)—Offsets 0xF_F030, 0xF30

Table 18-3 shows the bit definitions for WP1_CNTL_TRIG and WP2_CNTL_TRIG.

Table 18-3. Watchpoint Control Trigger Register Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–26	—	0b000_000	R	Reserved
25	QREQ	0b0	R/W	0 Trigger if $\overline{\text{QREQ}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{QREQ}}$ negated
24	QACK	0b0	R/W	0 Trigger if $\overline{\text{QACK}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{QACK}}$ negated
23	BR	0b0	R/W	0 Trigger if $\overline{\text{BR}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{BR}}$ negated
22	BG	0b0	R/W	0 Trigger if $\overline{\text{BG}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{BG}}$ negated
21	TS	0b0	R/W	0 Trigger if $\overline{\text{TS}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{TS}}$ negated
20–16	TT[0–4]	0b0_0000	R/W	Trigger match condition for TT[0:4] setting on peripheral logic bus
15	TBST	0b0	R/W	0 Trigger if $\overline{\text{TBST}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{TBST}}$ negated
14–12	TSIZ[0–2]	0b000	R/W	Trigger match condition for TSIZ[0:2] on peripheral logic bus
11	GBL	0b0	R/W	0 Trigger if $\overline{\text{GBL}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{GBL}}$ negated
10	CI	0b0	R/W	0 Trigger if $\overline{\text{CI}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{CI}}$ negated
9	WT	0b0	R/W	0 Trigger if $\overline{\text{WT}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{WT}}$ negated

Table 18-3. Watchpoint Control Trigger Register Bit Field Definitions (continued)

Bits	Name	Reset Value	R/W	Description
8	TC0	0b00	RW	Trigger match condition for TC0 on peripheral logic bus
7	TC1	0b00	RW	Trigger match condition for $\overline{\text{TC1}}$ on peripheral logic bus
6	AACK	0b0	R/W	0 Trigger if $\overline{\text{AACK}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{AACK}}$ negated
5	ARTRY	0b0	R/W	0 Trigger if $\overline{\text{ARTRY}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{ARTRY}}$ negated
4	DBG	0b0	R/W	0 Trigger if $\overline{\text{DBG}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{DBG}}$ negated
3	TA	0b0	R/W	0 Trigger if $\overline{\text{TA}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{TA}}$ negated
2	TEA	0b0	R/W	0 Trigger if $\overline{\text{TEA}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{TEA}}$ negated
1	INT	00b	R/W	0 Trigger if $\overline{\text{INT}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{INT}}$ negated
0	MCP	0b0	R/W	0 Trigger if $\overline{\text{MCP}}$ asserted on peripheral logic bus 1 Trigger if $\overline{\text{MCP}}$ negated

Figure 18-4 and Figure 18-5 show the format of the watchpoint #1 and watchpoint #2 address trigger registers (WP1_ADDR_TRIG and WP2_ADDR_TRIG). The format is identical, but they are shown separately to show the offsets.

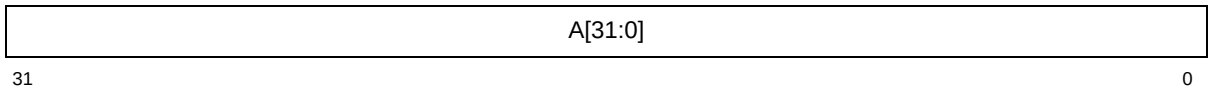


Figure 18-4. Watchpoint #1 Address Trigger Register (WP1_ADDR_TRIG)—Offsets 0xF_F01C, 0xF1C

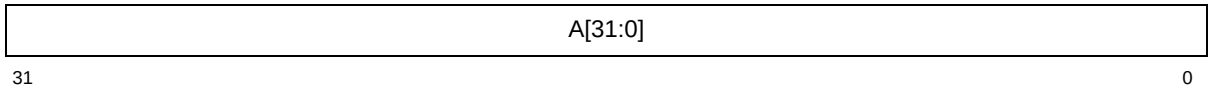


Figure 18-5. Watchpoint #2 Address Trigger Register (WP2_ADDR_TRIG)—Offsets 0xF_F034, 0xF34

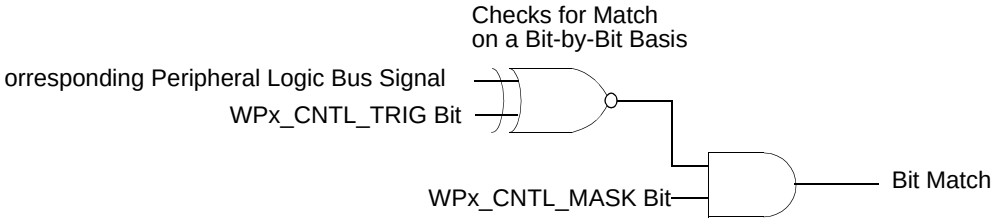
Table 18-4 shows the bit definitions for WP1_ADDR_TRIG and WP2_ADDR_TRIG.

Table 18-4. Watchpoint Address Trigger Register Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–0	A[31:0]	all 0s	R/W	Trigger value for peripheral logic address bus

18.3.3 Watchpoint Mask Registers

The watchpoint trigger masks are bit-wise ANDed with the corresponding watchpoint trigger bits that were compared with the current state of the peripheral logic address and control buses to detect watchpoint matches as shown in Figure 18-6. Thus, a one in any bit of a watchpoint mask register enables the compare of that watchpoint trigger bit and its corresponding signal on the peripheral logic. A value of zero in the mask register bit position causes that bit of the watchpoint trigger to be ignored. Note that all unmasked bits in the appropriate WPx_CNTL_TRIG register must match the value on the 60x bus to make a watchpoint match occur.



See Figure 18-13 for complete watchpoint match criteria.

Figure 18-6. Bit Match Generation for Watchpoint Trigger Bit Settings

Watchpoint #1 and #2 have separate watchpoint trigger mask registers for both the control and address portions. These registers are read/writable and are initialized to 0x0000_0000. The format of the WP1_CNTL_MASK and WP2_CNTL_MASK registers is shown in Figure 18-7 and Figure 18-8. Note that the format of these two registers is identical, but they are shown separately to emphasize that their locations are at different offsets.

ARTRY_NXT	Reserved	QREQ_	QACK_	BR_	BG_	TS_	TT0[0:4]	TBST_	TSIZ[0:2]	GBL_	CI_	WT_	TC0	TC1	AACK_	ARTRY_	DBG_	TA_	TEA_	INT_	MCP_
31	26	25	24	23	22	21	20	16	15	14	12	11	10	9	8	7	6	5	4	3	2	1	0

Figure 18-7. Watchpoint #1 Control Mask Register (WP1_CNTL_MASK)—Offsets 0xF_F020, 0xF20

ARTRY_NXT	Reserved	QREQ_	QACK_	BR_	BG_	TS_	TT0[0:4]	TBST_	TSIZ[0:2]	GBL_	CI_	WT_	TC0_	TC1_	AACK_	ARTRY_	DBG_	TA_	TEA_	INT_	MCP_
31	26	25	24	23	22	21	20	16	15	14	12	11	10	9	8	7	6	5	4	3	2	1	0

Figure 18-8. Watchpoint #2 Control Mask Register (WP2_CNTL_MASK)—Offsets 0xF_F038, 0xF38

Table 18-5 shows the bit definitions for WP1_CNTL_MASK and WP2_CNTL_MASK.

Table 18-5. Watchpoint Control Mask Register Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31	ARTRY_NXT	0b0	R/W	Trigger mask for the next cycle's 60x Address Retry (active low)
30–26	—	0b000000		Reserved
25	QREQ	0b0	R/W	0 Ignore $\overline{\text{QREQ}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{QREQ}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
24	QACK	0b0	R/W	0 Ignore $\overline{\text{QACK}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{QACK}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
23	BR	0b0	R/W	0 Ignore $\overline{\text{BR}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{BR}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
22	BG	0b0	R/W	0 Ignore $\overline{\text{BG}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{BG}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
21	TS	0b0	R/W	0 Ignore $\overline{\text{TS}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{TS}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
20–16	TT(0–4)	0b0_0000	R/W	Trigger mask for peripheral logic address transfer attribute
15	TBST	0b0	R/W	0 Ignore $\overline{\text{TBST}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{TBST}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
14–12	TSIZ(0–2)	0b000	R/W	Trigger mask for peripheral logic transfer size
11	GBL	0b0	R/W	0 Ignore $\overline{\text{GBL}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{GBL}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
10	CI	0b0	R/W	0 Ignore $\overline{\text{CI}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{CI}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
9	WT	0b0	R/W	0 Ignore $\overline{\text{WT}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{WT}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
8	TC0	0b00	RW	Trigger mask for peripheral logic transfer code
7	TC1	0b00	RW	Trigger mask for peripheral logic transfer code
6	AACK	0b0	R/W	0 Ignore $\overline{\text{AACK}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{AACK}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
5	ARTRY	0b0	R/W	0 Ignore $\overline{\text{ARTRY}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{ARTRY}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
4	DBG	0b0	R/W	0 Ignore $\overline{\text{DBG}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{DBG}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
3	TA	0b0	R/W	0 Ignore $\overline{\text{TA}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{TA}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
2	TEA	0b0	R/W	0 Ignore $\overline{\text{TEA}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{TEA}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
1	INT	0b0	R/W	0 Ignore $\overline{\text{INT}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{INT}}$ on peripheral logic bus with WPx_CNTL_TRIG bit
0	MCP	0b0	R/W	0 Ignore $\overline{\text{MCP}}$ trigger bit in WPx_CNTL_TRIG 1 Compare $\overline{\text{MCP}}$ on peripheral logic bus with WPx_CNTL_TRIG bit

Figure 18-9 and Figure 18-10 show the format of the watchpoint #1 and watchpoint #2 address mask registers (WP1_ADDR_MASK and WP2_ADDR_MASK). The format is identical, but they are shown separately to show the offsets.

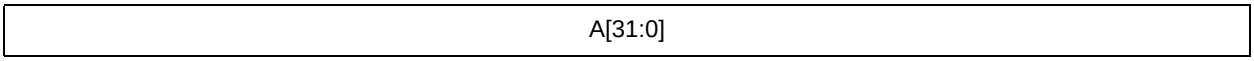


Figure 18-9. Watchpoint #1 Address Mask Register (WP1_ADDR_MASK)—Offsets 0xF_F024, 0xF24

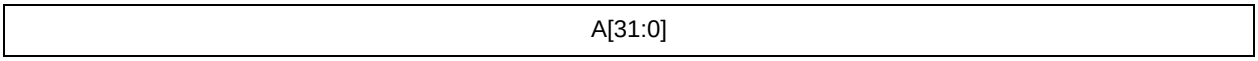


Figure 18-10. Watchpoint #2 Address Mask Register (WP2_ADDR_MASK)—Offsets 0xF_F03C, 0xF3C

Table 18-6 shows the bit field definitions for WP1_ADDR_MASK and WP2_ADDR_MASK.

Table 18-6. Watchpoint Address Mask Register Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31–0	A[31:0]	all 0s	R/W	Trigger mask for peripheral logic address bus

18.3.4 Watchpoint Control Register (WP_CONTROL)

The watchpoint control register configures the watchpoint facility, which has fields that allow the user to do the following:

- Enable the watchpoint facility
- Enable the debug addresses in software
- Enable watchpoint interrupts
- Initialize the watchpoint counters
- Select the driver modes for TRIG_OUT
- Set the watchpoint mode of operation

Figure 18-11 shows the format of WP_CONTROL.

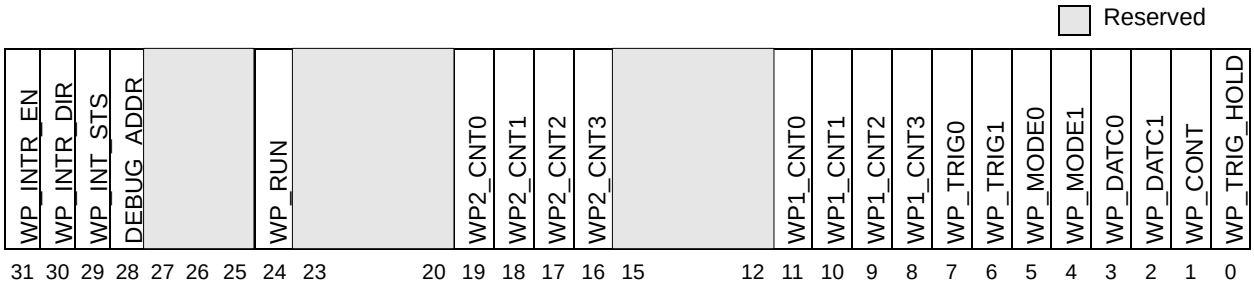


Figure 18-11. Watchpoint Control Register (WP_CONTROL)—Offsets 0xF_F048, 0xF48

Table 18-7 shows the bit field definitions for WP_CONTROL.

Table 18-7. Watchpoint Control Register Bit Field Definitions

Bits	Name	Reset Value	R/W	Description
31	WP_INTR_EN	0	R/W	The watchpoint interrupt enable bit is used to enable interrupts generated by the watchpoint facility. A watchpoint interrupt is defined as a trigger match. 0 Watchpoint interrupt disabled 1 Watchpoint interrupt enabled
30	WP_INTR_DIR	0	R/W	The watchpoint interrupt direction bit is used to select the target direction of a watchpoint interrupt. 0 Local interrupt ($\overline{\text{INT}}$ asserted on a watchpoint interrupt) 1 PCI interrupt ($\overline{\text{INTA}}$ asserted on a watchpoint interrupt)
29	WP_INTR_STS	0	Read/Write1 to clear	The watchpoint interrupt status bit is used to determine the status of the watchpoint interrupt. 0 A watchpoint interrupt has not occurred 1 A watchpoint interrupt has occurred This bit is sticky on ones. When set by hardware, it must be cleared by software by writing a one to this bit.
28	DEBUG_ADDR_	x	RW	Debug address disable. See Section 17.3, “Memory Debug Address,” for more information. 0 Debug address facility is enabled 1 Debug address facility is disabled Note that the reset value of this bit is determined by the $\overline{\text{GNT4}}$ signal. See Section 2.4, “Configuration Signals Sampled at Reset,” for more information.
27	WP_MODE[2]	0	R/W	Defines operation modes. See Table 18-8.
26–25	—	0b000	R	Reserved

Table 18-7. Watchpoint Control Register Bit Field Definitions (continued)

Bits	Name	Reset Value	R/W	Description
24	WP_RUN	0	R/W	The watchpoint run bit is used to start and stop a watchpoint scan. This is the only watchpoint register bit that should be changed by software while the watchpoint facility is enabled (WP_RUN = 1). This bit can also be toggled externally by pulsing the TRIG_IN signal if the watchpoint facility is not in the HOLD state. When the watchpoint facility is in the HOLD state, pulsing TRIG_IN causes the watchpoint facility to wake up and continue or conclude its scan as programmed. 0 Stop a watchpoint scan 1 Start a watchpoint scan
23–20	—	0b0000	R	Reserved
19–16	WP2_CNT[0–3]	0b0000	R/W	The watchpoint #2 counter field sets the initial value of the countdown counter for watchpoint #2. This counter is only used in watchpoint waterfall mode (WP_MODE = 0b01). 0000 16 0001 1 0010 2 ... 1111 15
15–12	—	0b0000	R	Reserved
11–8	WP1_CNT[0–3]	0b0000	R/W	The watchpoint #1 counter field sets the initial value of the countdown counter for watchpoint #1. This counter is used in all watchpoint operation modes. 0000 16 0001 1 0010 2 ... 1111 15
7–6	WP_TRIG[0–1]	0b00	R/W	The watchpoint trigger control field is used to select the driver modes of the TRIG_OUT signal as follows: 0x TRIG_OUT is disabled; TRIG_OUT is in high-impedance state. 10 TRIG_OUT is enabled as an active high output 11 TRIG_OUT is enabled as an active low output. To enable TRIG_OUT as active low bit 6 must be set before bit 7.
5–4	WP_MODE[0–1]	0b00	R/W	The watchpoint mode field is used to define the operation modes of the watchpoint facility. See Table 18-8.
3–2	WP_DATC[0–1]	0b00	R/W	The WPM data capture control field is used to define the data capture modes of the watchpoint monitor. Supported functions are the following: 00 Do not capture 60x data bus 01 Capture 60x data bus on the C_1th trigger match: T_1 while in single or waterfall mode T_1 or T_2 while in OR mode T_1 and not T_2 while in AND NOT mode 10 Enable memory data-path error injection/capture. 11 Capture 60x data bus on the C_2th trigger match: T_2 while in waterfall mode Not applicable while in single, OR, and AND NOT modes

Table 18-7. Watchpoint Control Register Bit Field Definitions (continued)

Bits	Name	Reset Value	R/W	Description
1	WP_CONT	0	R/W	The watchpoint continuous scan bit selects between continuous scan mode and one-shot scan mode. In continuous mode, the watchpoint facility continuously scans for trigger matches. Upon each occurrence of a trigger match, the watchpoint facility issues an output trigger (if programmed to do so) and begins a new scan for the next trigger match. The watchpoint facility continues to generate multiple output triggers until the watchpoint facility is explicitly disabled by the user by writing WP_RUN =0. In one-shot scan mode, the watchpoint facility scans for the first trigger match. Upon the first occurrence of the trigger match, the watchpoint facility issues an output trigger (if programmed to do so and automatically disables the watchpoint facility by writing WP_RUN = 0. Further trigger matches do not generate output triggers until the watchpoint facility is re-enabled by the setting of WP_RUN = 1 or the assertion of TRIG_IN. 0 One-shot scan mode 1 Continuous scan mode
0	WP_TRIG_HOLD	0	R/W	Trigger hold enable. When trigger hold mode is enabled, the watchpoint facility enters a HOLD state upon a trigger match. Additionally, the TRIG_OUT signal remains asserted while the watchpoint facility remains in the HOLD state. The watchpoint facility can be resumed from this HOLD state by pulsing TRIG_IN. Pulsing the TRIG_IN signal while in the HOLD state does not toggle the WP_RUN bit. 0 Trigger hold disabled 1 Trigger hold enabled

Table 18-8 describes the modes selected by the WP_MODE field of the WP_CONTROL register.

Table 18-8. Watchpoint Monitor Mode Select

WPM_MODE [0–2]	Definition	Watchpoint #1 Trigger(T_1)	Watchpoint #1 Counter(C_1)	Watchpoint #2 Trigger(T_2)	Watchpoint #2 Counter(C_2)
000	Single mode: Latch watchpoint #1 monitor registers and generate output trigger after C_1th occurrence of the masked trigger for watchpoint #1.	√	√	na	na
001	Reserved	—	—	—	—

Table 18-8. Watchpoint Monitor Mode Select (continued)

WPM_MODE [0–2]	Definition	Watchpoint #1 Trigger(T_1)	Watchpoint #1 Counter(C_1)	Watchpoint #2 Trigger(T_2)	Watchpoint #2 Counter(C_2)
010	Waterfall mode: Latch watchpoint #1 monitor registers after C_1th occurrence of the masked trigger for watchpoint #1 and THEN latch watchpoint #2 monitor registers and generate output trigger after the C_2th occurrence of the masked trigger for watchpoint #2. Waterfall mode is inherently serial; i.e., the final watchpoint match for trigger #1 must occur before the machine starts counting occurrences of watchpoint matches for trigger #2.	√	√	√	√
011	Cascade mode: Same as waterfall mode, except that the first watchpoint match for trigger #2 can occur coincident with the final watchpoint match for trigger #1.	√	√	√	√
100	OR mode: Latch watchpoint #1 monitor registers and generate output trigger after C_1th occurrence of the masked trigger for watchpoint #1 OR the masked trigger for watchpoint #2.	√	√	√	na
101	Reserved	—	—	—	—
110	AND NOT mode: Latch watchpoint #1 monitor registers and generate output trigger after C_1th occurrence of the masked trigger for watchpoint #1 AND NOT the masked trigger for watchpoint #2.	√	√	√	na
111	Reserved	—	—	—	—

18.4 State and Block Diagrams

Figure 18-12 shows a state diagram of the watchpoint facility.

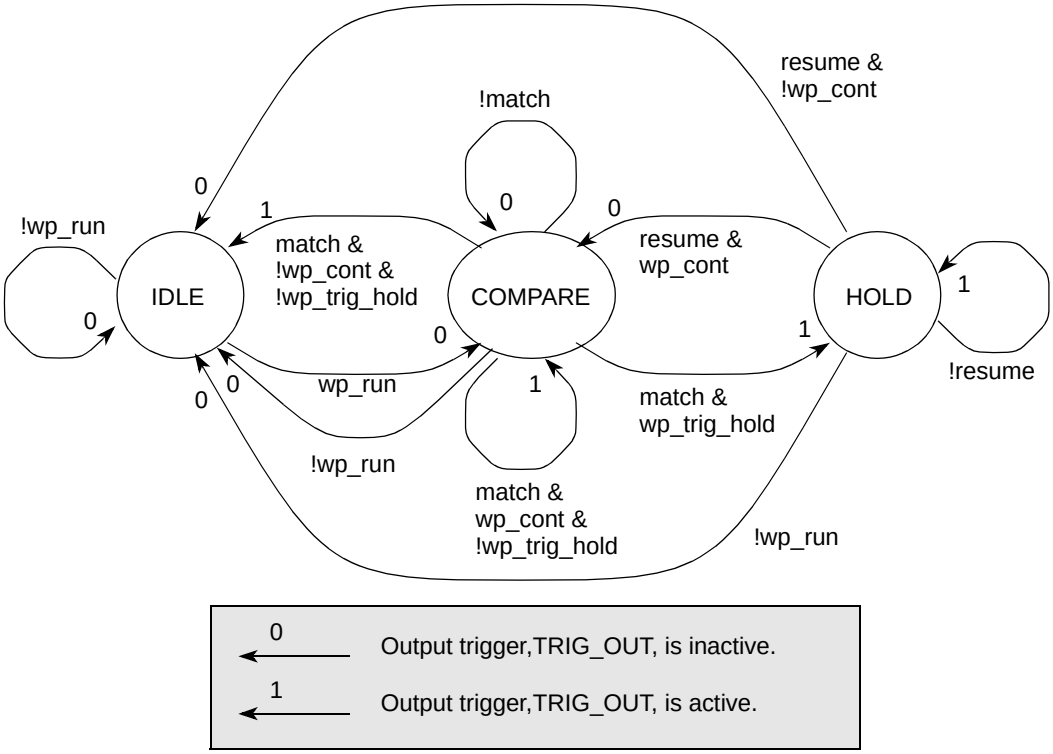


Figure 18-12. Watchpoint Facility State Diagram

Figure 18-13 shows a block diagram of the watchpoint facility.

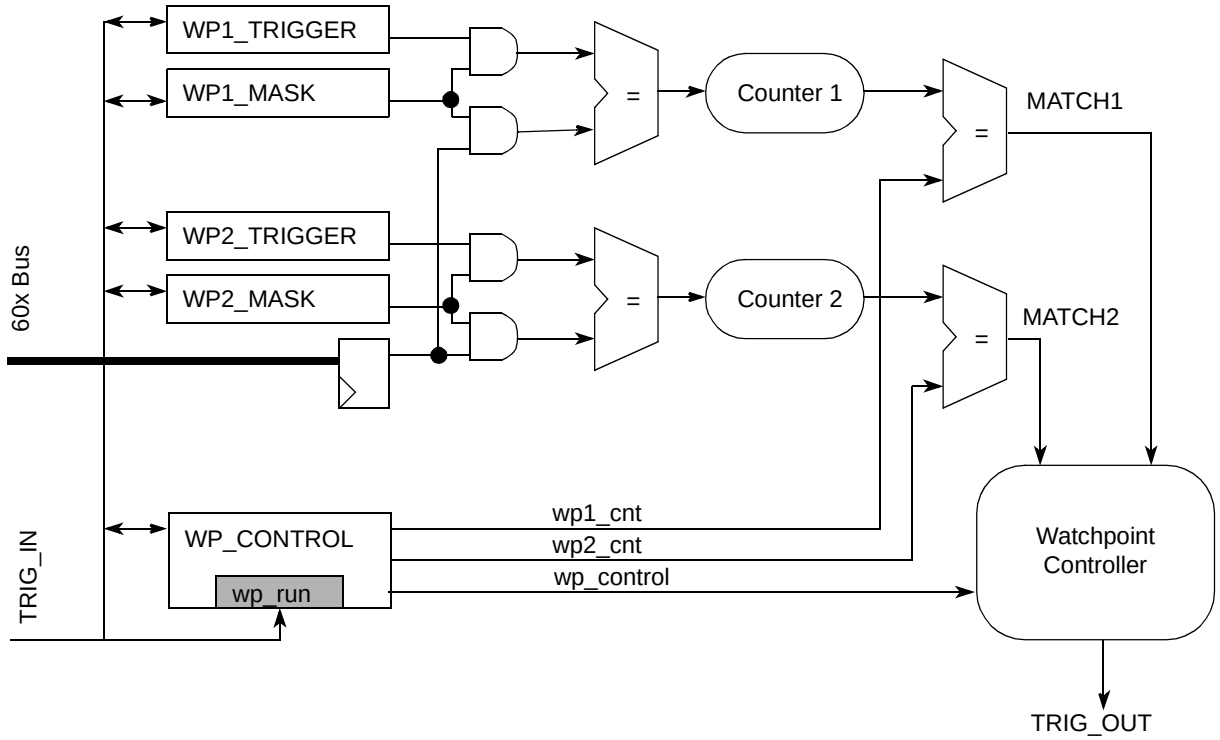


Figure 18-13. Watchpoint Facility Block Diagram

18.5 Watchpoint Trigger Applications

The watchpoint facility output trigger can initiate a halt to the processor core through the checkstop signals. When the processor clock is stopped, the internal state of the processor can be scanned out through the JTAG port (TDO) using emulators available from third party tool developers.

Another example for the TRIG_OUT signal is as follows. If an MPC8245 bridge device and local processor are on a PC add-in card, the firmware polls the add-in slots and might enable the MPC8245 as a PCI master before the driver code is able to set up the address translation unit of the MPC8245. The processor accesses out of reset are not directed to the correct PCI memory locations. In this case, with a weak pull-down resistor, TRIG_OUT from the MPC8245 can be used as the $\overline{\text{HRESET}}$ signal to the local processor (the default state of TRIG_OUT is high impedance). The add-in card driver software can first configure the MPC8245 address translation unit and negate $\overline{\text{HRESET}}$ to the local processor in a controlled way by writing 0b11 to WP_TRIG[0–1]. This example uses TRIG_OUT as a simple programmable output signal, but does not use the watchpoint triggers and compare functions.

Appendix A
Bit and Byte Ordering

The MPC8245 supports two byte ordering conventions for the PCI bus and local memory—big-endian and little-endian. This appendix describes both modes and provides examples of each. Chapter 3, “Operand Conventions,” in *The Programming Environments Manual*, provides a general overview of byte ordering and describes byte ordering for microprocessors that implement the PowerPC architecture.

A.1 Byte Ordering Overview

For big-endian data, the MSB is stored at the lowest (or starting) address and the LSB at the highest (or ending) address. This arrangement is called *big-endian* because the big (most-significant) end of the scalar comes first in memory.

For true little-endian byte ordering, the LSB is stored at the lowest address and the MSB at the highest address. This arrangement is called true *little-endian* because the little (least-significant) end of the scalar comes first in memory.

For modified little-endian byte ordering (also called *munged* little-endian), the address of data is modified so that the memory structure appears to be little-endian to the executing processor when, in fact, the byte ordering is big-endian. The address modification is called *munging*. Note that the term ‘munging’ is not defined or used in the PowerPC architecture specification, but is commonly used to describe address modifications.

In addition, the PCI bus uses a bit format where the most-significant bit (msb) for data is AD31, while the processor core and the internal peripheral logic data bus use a bit format where the msb is DH0. Thus, PCI data bit AD31 equates to the processor’s data bits DH0 and DL0, while PCI data bit AD0 equates to the processor’s data bits DH31 and DL31.

A.2 Byte Ordering Mechanisms

The byte ordering mechanisms in the MPC8245 are controlled by programmable parameters. The PowerPC architecture defines two bits in a processor’s machine state register (MSR) for specifying byte ordering—LE (little-endian mode) and ILE (exception little-endian mode). For the MPC8245, these bits control only the addresses generated by the G2 processor core. The LE bit specifies the endian mode for normal core operation and

ILE specifies the mode to be used when an exception handler is invoked. That is, when an exception occurs, the ILE bit (as set for the interrupted process) is copied into MSR[LE] to select the endian mode for the context established by the exception. The LE and ILE bits control a 3-bit address modifier in the processor core.

To convert from modified little-endian to true little-endian byte ordering, all the byte lanes must be reversed (MSB to LSB, and so on) and the addresses must be unmunged external to the processor core. When configured for little-endian mode, the MPC8245 unmunges the address and reverses the byte lanes between the PCI bus and local memory in the central control unit (CCU). This means that the data in local memory is stored using modified little-endian byte ordering, but data on the PCI bus is in true little-endian byte order. The PICR1[LE_MODE] parameter controls a 3-bit address modifier and byte lane swapper in the CCU.

Note that the processor core and the CCU should be set for the same endian mode before accessing devices on the PCI bus.

A.3 Big-Endian Mode

When the processor core is operating in big-endian mode, no address modification is performed by the processor. In big-endian mode, the MPC8245 maintains the big-endian byte ordering on the PCI bus during the data phase(s) of PCI transactions. The byte lane translation for big-endian mode is shown in Table A-1. Note that the bit ordering on the PCI bus remains unchanged (that is, AD31 is still the msb of the byte in byte lane 3 and AD0 is still the lsb of the byte in byte lane 0).

Table A-1. Byte Lane Translation in Big-Endian Mode

Processor Byte Lane	Processor Data Bus Signals	PCI Byte Lane	PCI Address/Data Bus Signals During PCI Data Phase
0	DH[0–7]	0	AD[7–0]
1	DH[8–15]	1	AD[15–8]
2	DH[16–23]	2	AD[23–16]
3	DH[24–31]	3	AD[31–24]
4	DL[0–7]	0	AD[7–0]
5	DL[8–15]	1	AD[15–8]
6	DL[16–23]	2	AD[23–16]
7	DL[24–31]	3	AD[31–24]

Figure A-1 shows a 4-byte write to PCI memory space in big-endian mode.

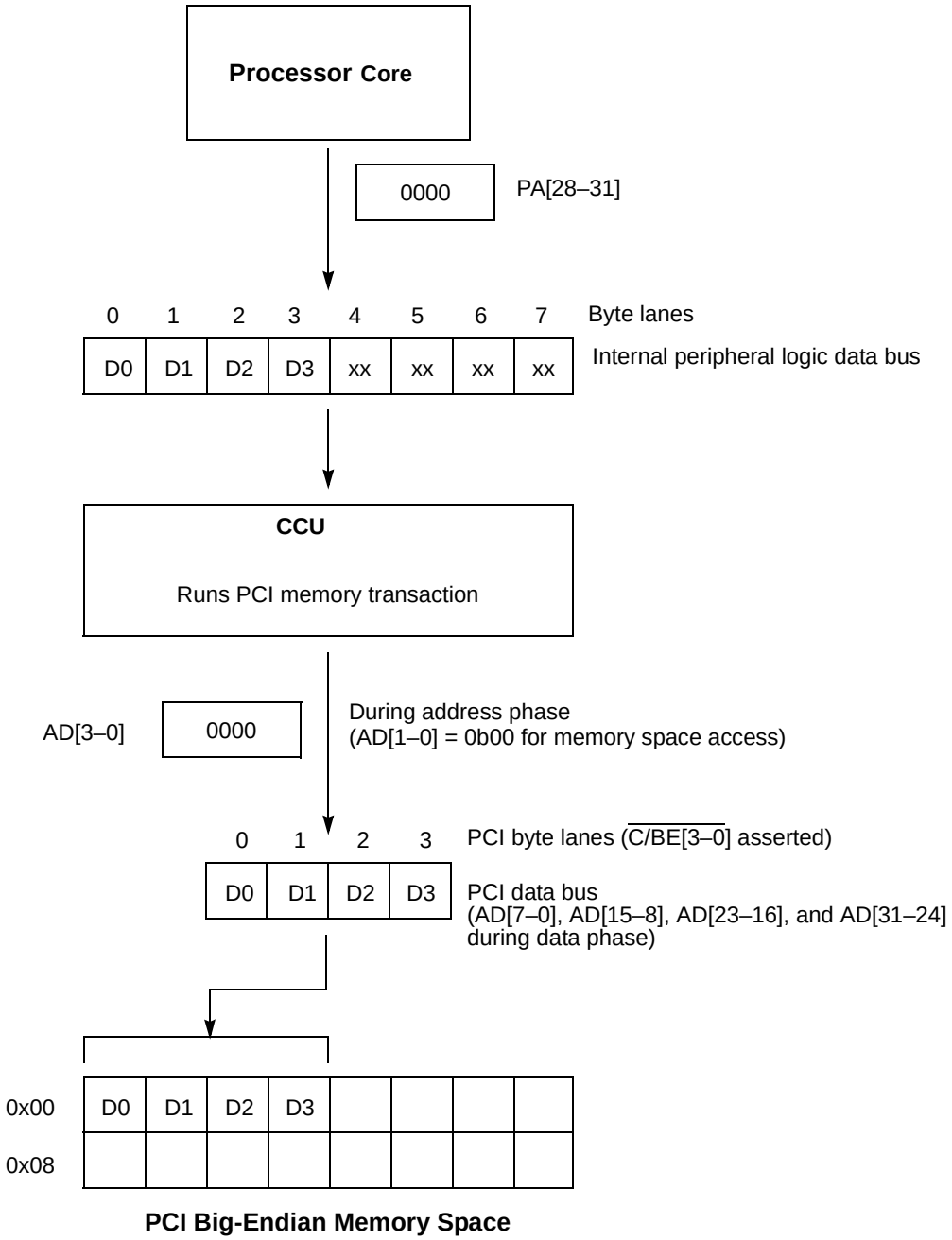


Figure A-1. Four-Byte Transfer to PCI Memory Space—Big-Endian Mode

Note that the MSB on the internal peripheral logic bus, D0, is placed on byte lane 0 (AD[7–0]) on the PCI bus. This occurs so D0 appears at address 0x*nnnn_nn*00 and not at address 0x*nnnn_nn*03 in the PCI space.

The following example demonstrates the operation of a system in big-endian mode, starting with a program that does the following:

```
store string (“hello, world”) at 0x000
store pointer (0xFEDCBA98) at 0x010
store half word (0d1234) at 0x00E
store byte (0x55) at 0x00D
```

If the data is stored into local memory, it appears as shown in Figure A-2.

Contents	‘h’	‘e’	‘l’	‘l’	‘o’	‘,’	‘ ’	‘w’
Address	**00**	**01**	**02**	**03**	**04**	**05**	**06**	**07**
Contents	‘o’	‘r’	‘l’	‘d’		0x55	12	34
Address	**08**	**09**	**0A**	**0B**	**0C**	**0D**	**0E**	**0F**
Contents	0xFE	0xDC	0xBA	0x98				
Address	**10**	**11**	**12**	**13**	**14**	**15**	**16**	**17**

Figure A-2. Big-Endian Memory Image in Local Memory

Note that the stored data has big-endian ordering. The ‘h’ is at address 0x000.

If the data is stored to the PCI memory space, it appears as shown in Figure A-3.

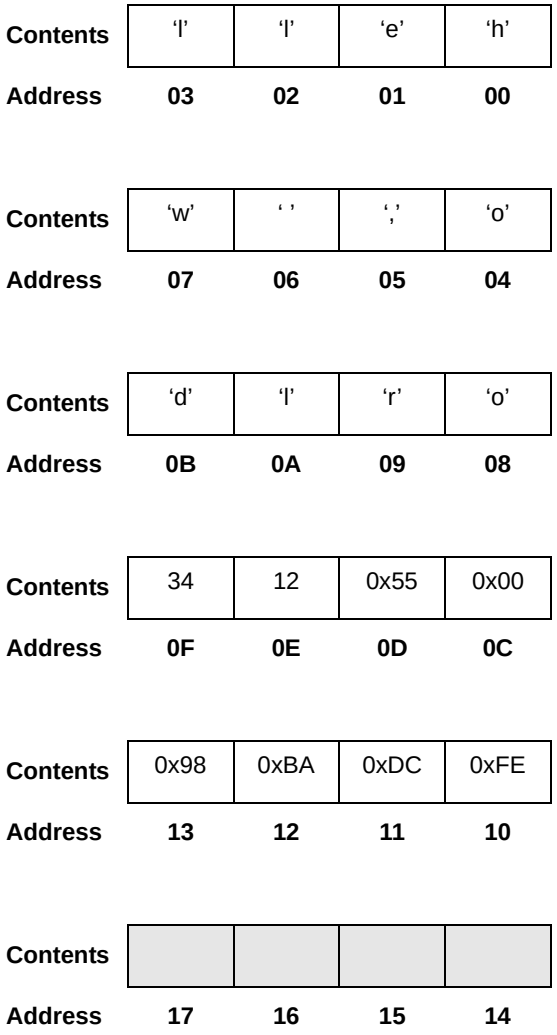


Figure A-3. Big-Endian Memory Image in Big-Endian PCI Memory Space

Note that the string 'hello, world' starts at address 0x000. The other data is stored to the desired location with big-endian byte ordering.

A.4 Little-Endian Mode

When the processor core is operating in little-endian mode, its internal BIU modifies each address. This modification is called munging. The processor munges the address by exclusive-ORing (XOR) the three low-order address bits with a three-bit value that depends on the length of the operand (1, 2, 4, or 8 bytes), as shown in Table A-2.

Table A-2. Processor Address Modification for Individual Aligned Scalars

Data Length (in Bytes)	Address Modification A[29–31]
8	No change
4	XOR with 0b100
2	XOR with 0b110
1	XOR with 0b111

Note that munging makes individually aligned scalars appear to the processor as stored in little-endian byte order when, in fact, they are stored in big-endian order but at different byte addresses within double words. Only the address is modified, not the byte order.

The munged address is used by the memory interface of the MPC8245 to access local memory. To provide true little-endian byte ordering to the PCI bus, the MPC8245 unmunges the address to its original value and the byte lanes are reversed. The MPC8245 unmunges aligned addresses by XORing the three low-order address bits with a three-bit value that depends on the length of the operand (1, 2, 3, 4, or 8 bytes), as shown in Table A-3.

Table A-3. MPC8245 Address Modification for Individual Aligned Scalars

Data Length (in Bytes)	Address Modification A[29–31]
8	No change
4	XOR with 0b100
3	XOR with 0b101
2	XOR with 0b110
1	XOR with 0b111

The MPC8245 also supports misaligned 2-byte transfers that do not cross word boundaries in little-endian mode. The MPC8245 XORs the address with 0x100. Note that the MPC8245 does not support 2-byte transfers that cross word boundaries in little-endian mode.

The byte lane translation for little-endian mode is shown in Table A-4.

Table A-4. Byte Lane Translation in Little-Endian Mode

Processor Byte Lane	Processor Data Bus Signals	PCI Byte Lane	PCI Address/Data Bus Signals During PCI Data Phase
0	DH[0–7]	3	AD[31–24]
1	DH[8–15]	2	AD[23–16]
2	DH[16–23]	1	AD[15–8]
3	DH[24–31]	0	AD[7–0]
4	DL[0–7]	3	AD[31–24]
5	DL[8–15]	2	AD[23–16]
6	DL[16–23]	1	AD[15–8]
7	DL[24–31]	0	AD[7–0]

Starting with the same program as before:

```
store string (“hello, world”) at 0x000
store pointer (0xFEDCBA98) at 0x010
store half word (0d1234) at 0x00E
store byte (0x55) at 0x00D
```

If the data is stored to local memory in little-endian mode, the MPC8245 stores the data to the munged addresses in local memory as shown in Figure A-4.

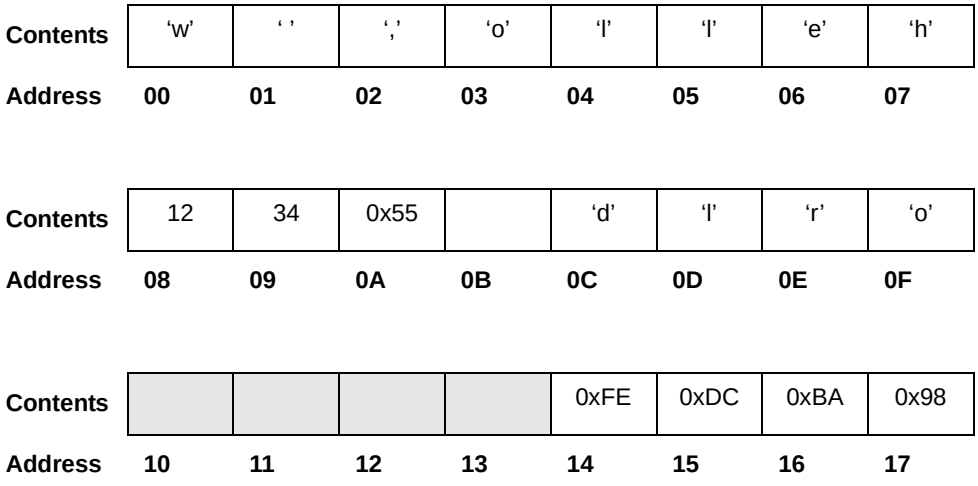


Figure A-4. Munged Memory Image in Local Memory

The image shown in Figure A-4 is not a true little-endian mapping. Note how munging has changed the addresses of the data. The ‘h’ is now at address 0x007. Also note that the byte ordering of the 4-byte pointer, 0xFEDCBA98, is big-endian; only the address has been modified. However, because the processor core munges the address when accessing local memory, the mapping appears little-endian to the processor core.

If the data is stored to the PCI memory space, or if a PCI agent reads from local memory, the MPC8245 unmunges the addresses and reverses the byte ordering before sending the data out to the PCI bus. The data is stored to little-endian PCI memory space as shown in Figure A-5.

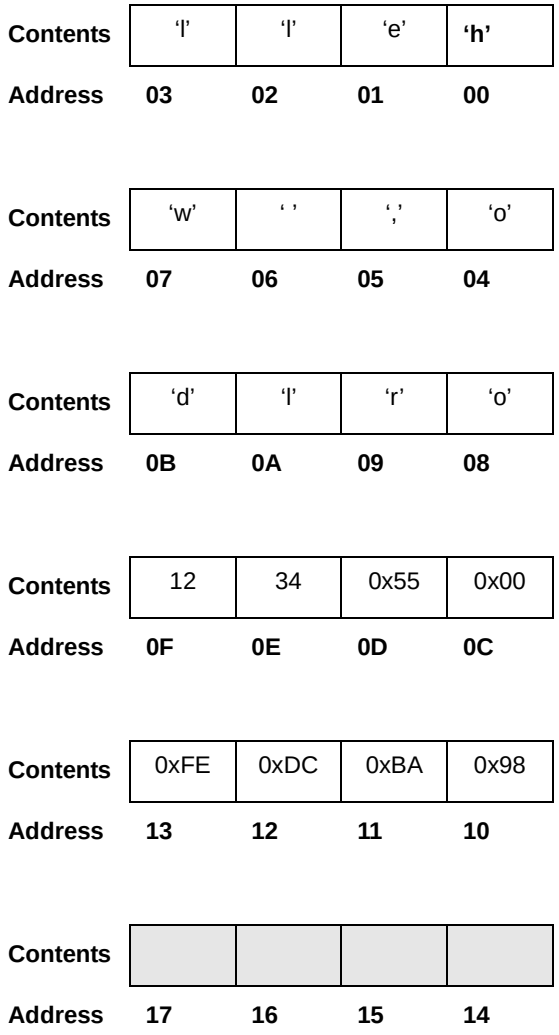


Figure A-5. Little-Endian Memory Image in Little-Endian PCI Memory Space

Note that the string ‘hello, world’ starts at address 0x000. The other data is stored to the desired location with true little-endian byte ordering.

Figure A-6 through Figure A-11 show the munging/unmunging process for transfers to the PCI memory space and to the PCI I/O space.

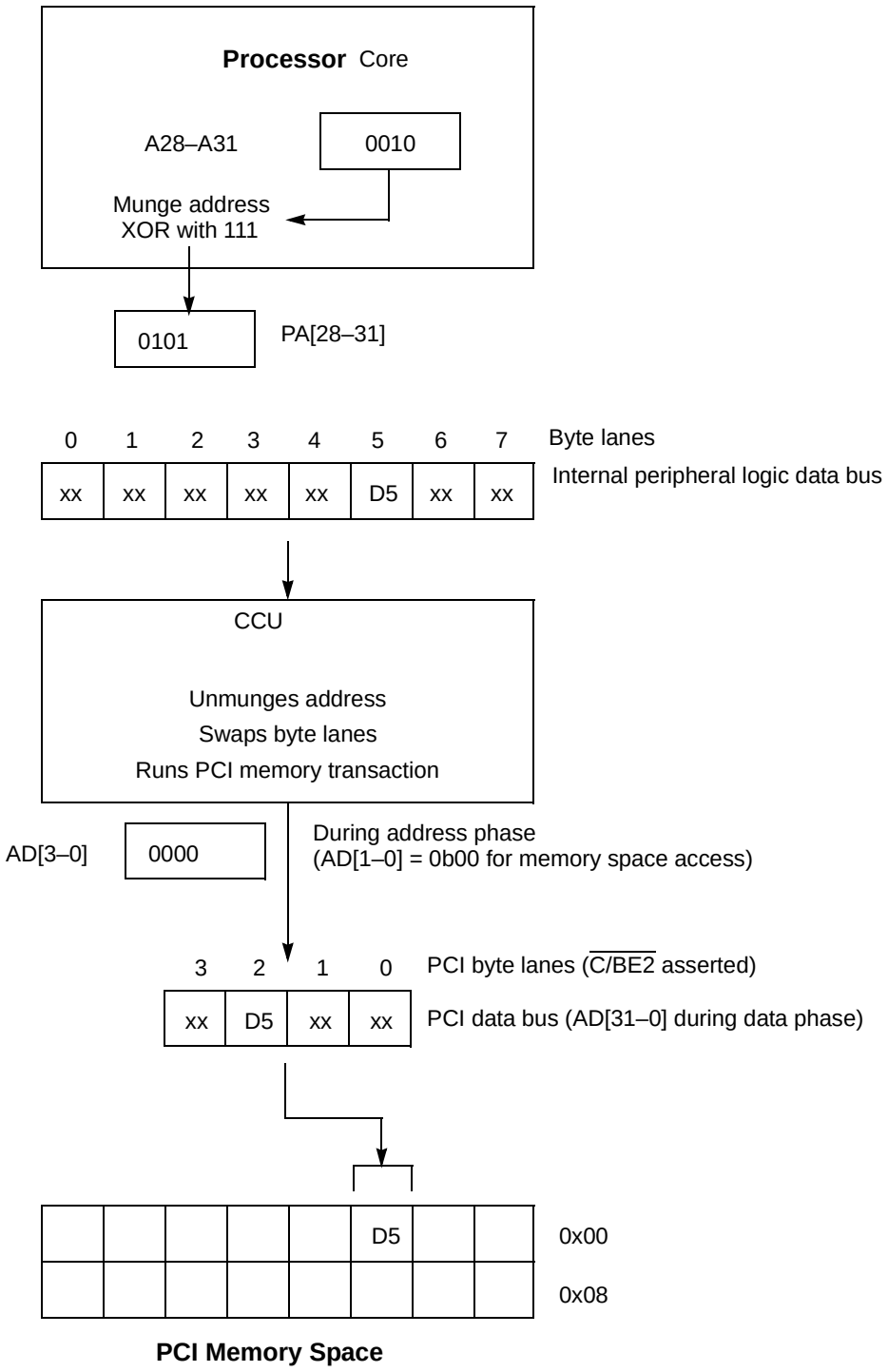


Figure A-6. One-Byte Transfer to PCI Memory Space—Little-Endian Mode

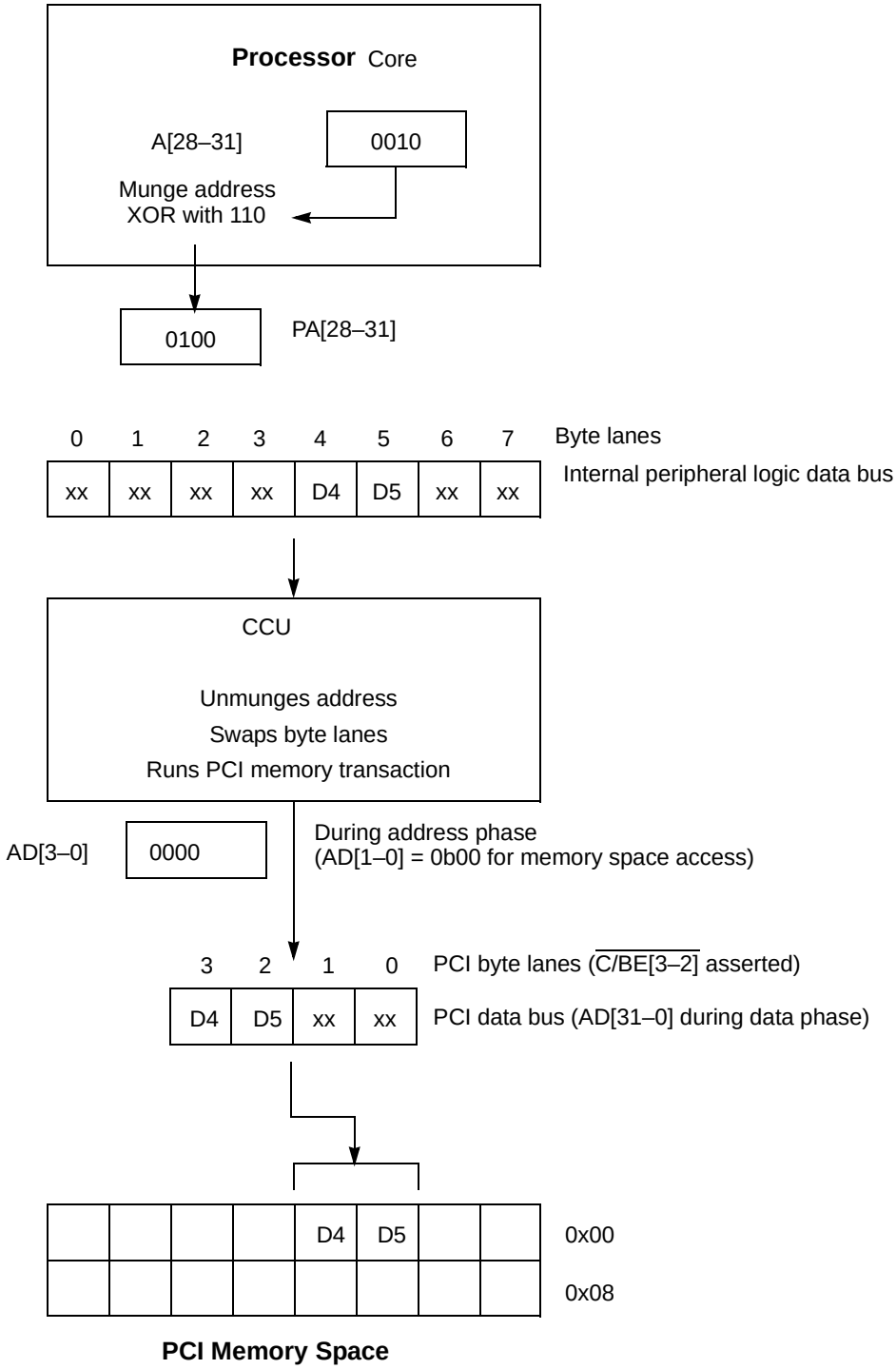


Figure A-7. Two-Byte Transfer to PCI Memory Space—Little-Endian Mode

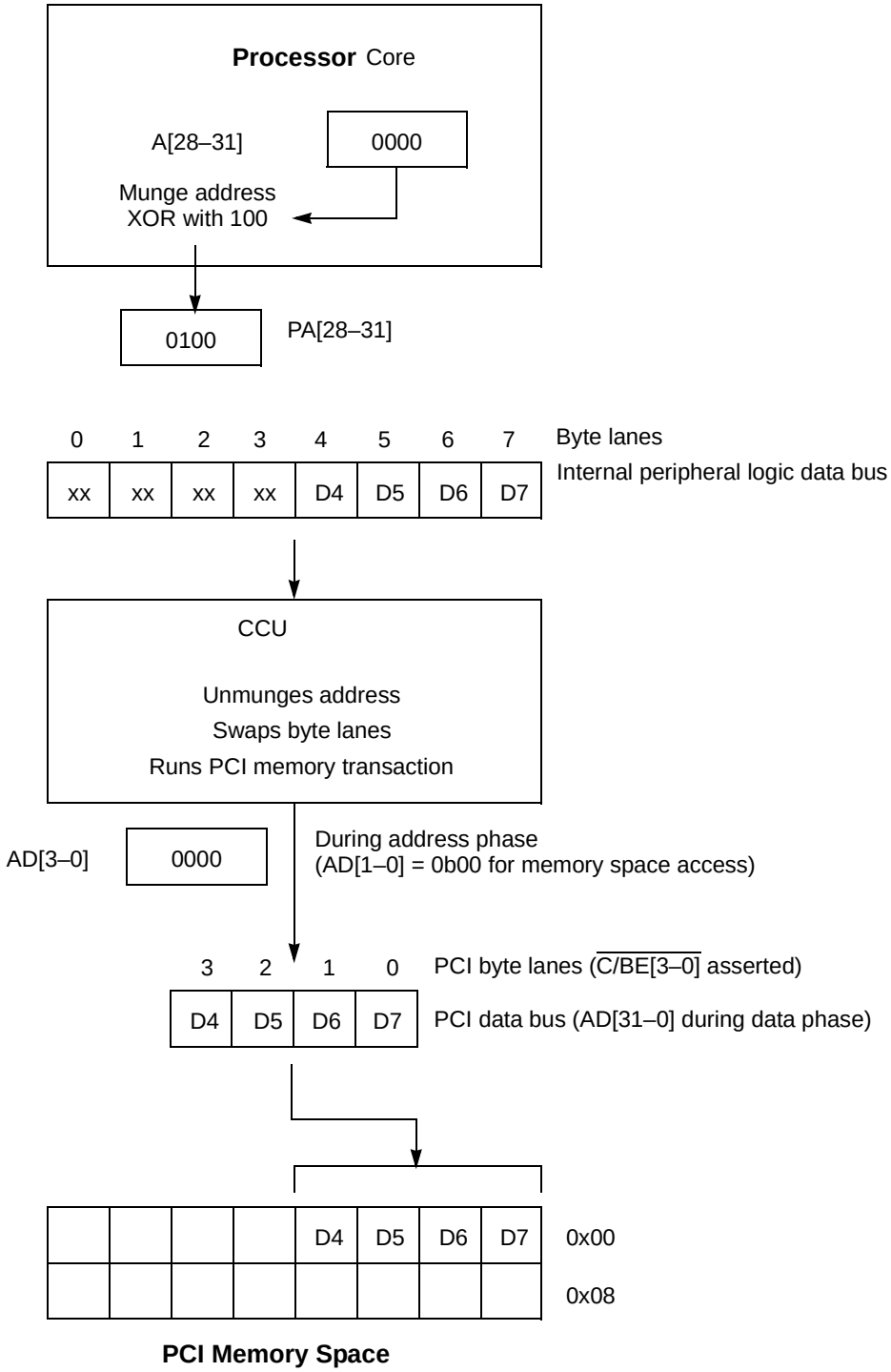


Figure A-8. Four-Byte Transfer to PCI Memory Space—Little-Endian Mode

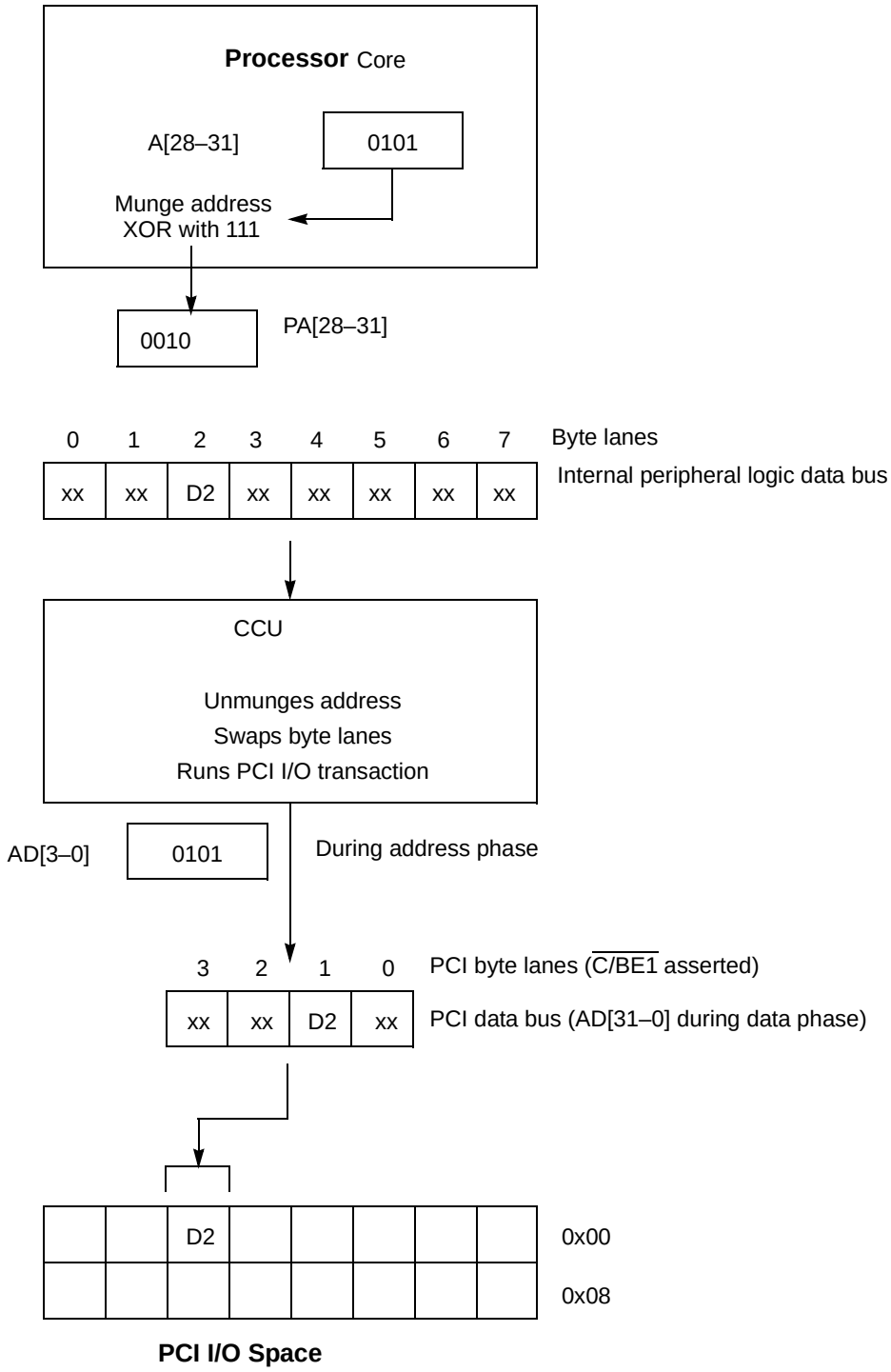


Figure A-9. One-Byte Transfer to PCI I/O Space—Little-Endian Mode

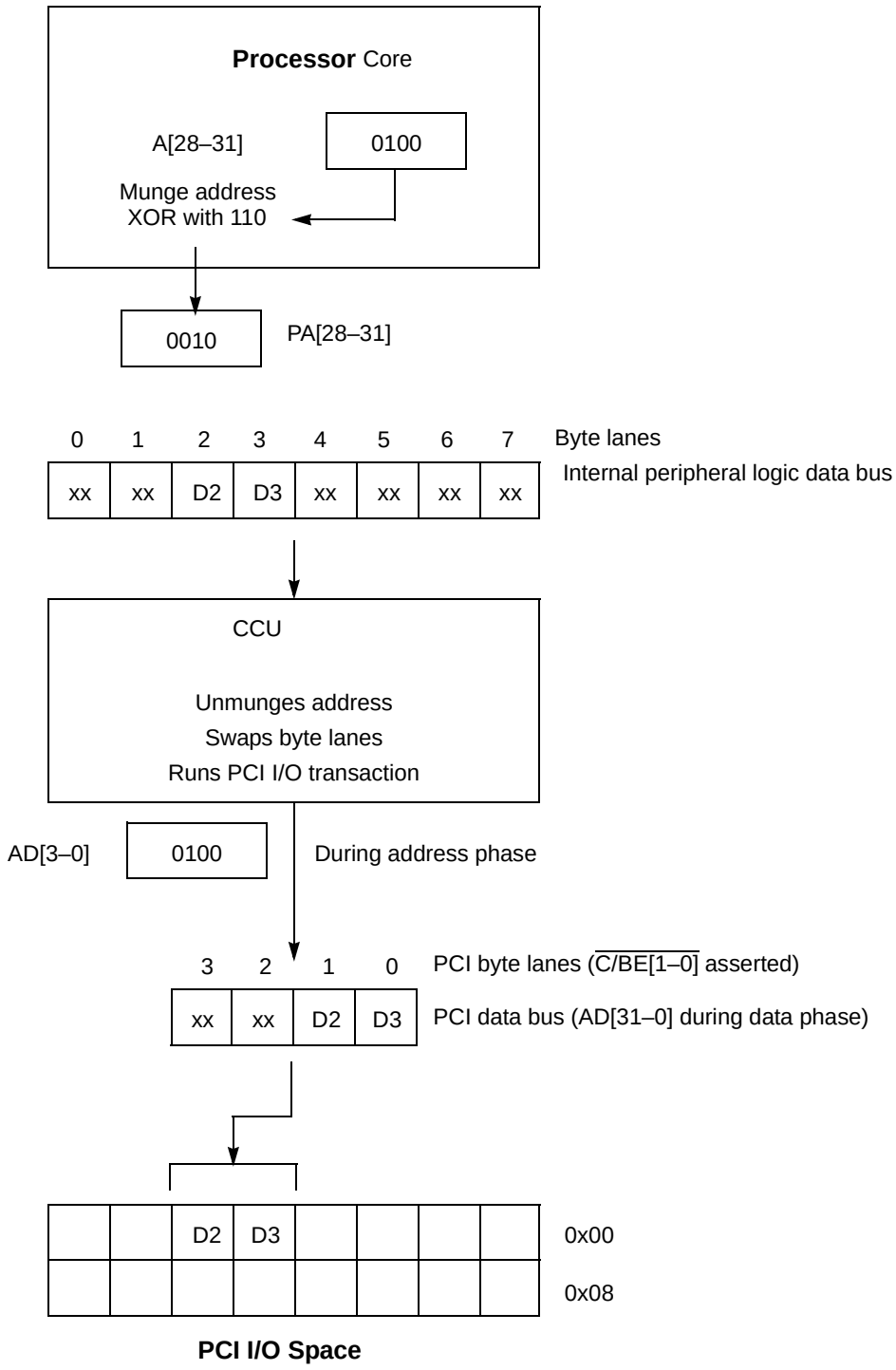


Figure A-10. Two-Byte Transfer to PCI I/O Space—Little-Endian Mode

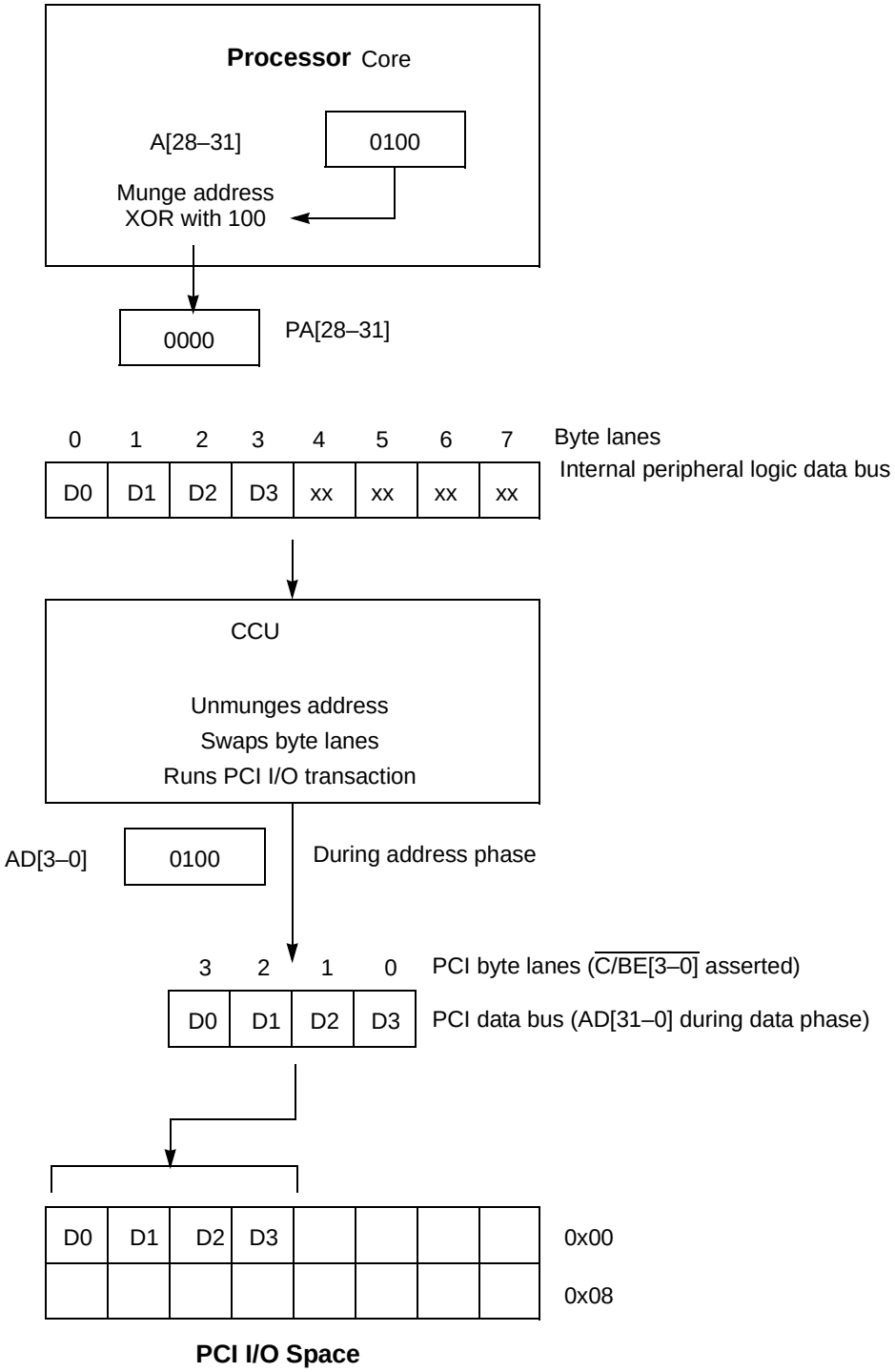


Figure A-11. Four-Byte Transfer to PCI I/O Space—Little-Endian Mode

A.4.1 I/O Addressing in Little-Endian Mode

For a system running in big-endian mode, both the processor core and the memory subsystem recognize the same byte as byte 0. However, this is not true for a system running in little-endian mode because of the munged address bits when the MPC8245 accesses external memory.

For I/O transfers in little-endian mode to transfer bytes properly, they must be performed as if the bytes transferred were accessed one at a time using the little-endian address modification appropriate for the single-byte transfers (that is, the lowest order address bits must be XORed with 0b111). I/O operations in little-endian systems need not be performed using only one-byte-wide transfers. Data transfers can be as wide as desired, but the order of the bytes within double words must be as if they were fetched or stored one at a time. That is, for a true little-endian I/O device, the system must provide a way to munge and unmunge the addresses and reverse the bytes within a double word (MSB to LSB).

A load or store that maps to a control register on an external device may require the bytes of the register data to be reversed. If this reversal is required, the load and store with byte-reverse instructions (**lhbrx**, **lwbrx**, **sthbrx**, and **stwbrx**) may be used.

A.5 Setting the Endian Mode of Operation

The MPC8245 powers up in big-endian mode. The endian mode should be set early in the initialization routine and remain unchanged for the duration of system operation. To switch between the different endian modes of operation, the processor core must run in serialized mode and the caches must be disabled. Motorola recommends avoiding any switching back and forth between endian modes.

To switch the system from big-endian to little-endian mode, the LE and ILE bits in the processor core's MSR should be set using an **mtmsr** instruction that resides on an odd word boundary (A[29] = 1). The instruction that is executed next is fetched from this address plus 8. (If the **mtmsr** instruction resides on an even word boundary (A[29] = 0), the instruction is executed twice because the address of little-endian mode is munged.) After the processor core are programmed for little-endian mode, the PICR1[LE_MODE] parameter in the peripheral control logic is set.

To switch the system from little- to big-endian mode, the LE and ILE bits in the processor core's MSR are cleared using an **mtmsr** instruction that resides on an even word boundary (A[29] = 0). The instruction that is executed next is fetched from this address plus 12. After the processor core is programmed for big-endian mode, the PICR1[LE_MODE] parameter in the peripheral control logic is cleared.

Appendix B
Initialization Example

This appendix contains an example PowerPC assembly language routine for initializing the configuration registers for the MPC8245 using address map B. It is excerpted from DINK32 source code available for download at http://www.motorola.com/semiconductors. DINK32 source code also contains examples that show initialization of the embedded utilities (PIC, DMA, MU, DUART, and I^2C).

```
/* entry: r3 contains MPC8245 Vendor ID */


MPC8245Init:


        // save MPC8245 Vendor ID
        or    r11, r3, r3


        // If the MPC8245 is detected, it must be running on a
        // Sandpoint with the Unity (PPMC8245) board (or possibly
        // a Yellowknife X4 with an adapter card).
        // The board_type of Sandpoint+PMC8245 X4 is 4. This code
        // stores the value 4 to sprg0, which will be stored to the
        // board_type variable after DINK is copied form ROM to RAM.


        addi    r3, r0, 0x4
        mtspr   sprg0, r3


// Errata to address latency timer RP 7/20/99
        lis     r3,BMC_BASE     // Set LATENCY_TIMER
        ori         r3,r3,0x000d
        li      r4, 0x20      // Set to 0x20
```

```
stwbrx    r3,0,r5
sync
stb  r4, 1(r6)
sync

lis     r3, BMC_BASE    // Set CACHE_LINE_SIZE
ori     r3,r3,0x000c
li      r4, 0x08      // Set to 0x08

stwbrx  r3,0,r5
sync
stb  r4, 0(r6)
sync

lis     r3,r0,BMC_BASE  // Set PCI_CMD
ori         r3,r3,0x0004
li      r4, 0x0006      // Set to 06 (Memory Space)

stwbrx  r3,0,r5
sync
sthbrx  r4, 0, r6
sync

lis     r3, BMC_BASE    // Set PCI_STAT
ori     r3,r3,0x0006
stwbrx  r3,0,r5
sync

li      r3, 0x0002
lhbrx   r4, r3, r6         // Get old PCI_STAT
sync
```

```
        ori     r4, r4, 0xffff     // Writing all ones will clear all bits in
        sthbrx  r4, r3, r6         // write the modified data to CONFIG_DATA

//-------PICR1

        lis     r3, BMC_BASE    // Set PICR1 (A8)
        ori     r3,r3,PROCINTCONF1
        stwbrx  r3,0,r5
        sync

        lwbrx   r4,0,r6                 // Get PICR1 bits

        lis     r3,0x0011
        ori     r3,r3,0x0010            // preserve POR bits.
        and     r4,r4,r3

        lis     r3,0x0004               // processor type = 603
        ori     r3,r3,0x1000            // enable Flash write
        ori     r3,r3,0x0800            // enable MCP* assertion
        ori     r3,r3,0x0200            // enable data bus parking
        ori     r3,r3,0x0040            // enable PCI store gathering
        ori     r3,r3,0x0010            // LOOP_SNOOP -- must set:
        ori     r3,r3,0x0008            // enable address bus parking
//      ori     r3,r3,0x0004            // enable speculative PCI reads

        or      r4,r4,r3          // Set new config bits
        stwbrx  r4,0,r6
        sync

//-------PICR2

        lis  r3,BMC_BASE        // Set PICR2 (AC)
```

```
        ori    r3,r3,PROCINTCONF2
        stwbrx r3,0,r5
        sync
        lis     r3,0x0000
//      oris    r3,r3,0x2000            // Disable Serialize Config cycles
//      oris    r3,r3,0x0800            // Disable PCI Snoop cycles
        oris    r3,r3,0x0400            // FF0 is Local ROM
//      oris    r3,r3,0x0200            // Flash write lockout

// CF_SNOOP_WS - set to 00 unless 1:1 or 3:2 CPU:BUS speeds
        oris    r3,r3,0x0000            // NORM: snoop wt states = 0
//      oris    r3,r3,0x0004            // SLOW: snoop wt states = 1
        stwbrx  r3,0,r6

//------ Embedded Utility Memory Block Base Address Register( EUMBBAR )

        lis  r3, BMC_BASE           // EUMBBAR (78) = 0xFC00_0000
        ori    r3,r3,0x0078
        stwbrx r3,0,r5

        lis    r4,0xfc00// Don't forget to map this area
        stwbrx r4,0,r6  // into the BATs
        sync

//! ===MCCR1=== MEMORY CONTROL CONFIGURATION
//!

        lis     r3, BMC_BASE           // MCCR1 (F0) = 0x8800_0000
        ori    r3,r3,0x00F0
        stwbrx r3,0,r5
        sync
```

```
        lwbrx   r7,0,r6                 // Get MCCR1 bits; used w/MCCR4
        lis     r3,0x0040
        and     r7,r7,r3                // R7:  =0 if 32 bits, /= 0 if 64.

        lis     r4,0x7580               // Safe Local ROM = 11+3 clocks
//      oris    r4,r4,0x0010            // Burst ROM/Flash enable
        ori    r4,r4,0x0000// Set all banks to 64Mbit, 4 bank parts
        stwbrx r4,0,r6
        sync

//! ===MCCR2=== MEMORY CONTROL CONFIGURATION
//!
        lis r3, BMC_BASE// Select MCCR2 (F4)
        ori    r3,r3,0x00F4
        stwbrx r3,0,r5
        sync

        lis    r4, 0x0000          // Self-Refresh value
//      oris    r4,r4,0x4000            // TS_WAIT_TIMER = 3 clocks
        oris    r4,r4,0x0400            // ASRISE = 2 clocks
        oris    r4,r4,0x0040            // ASFALL = 2 clocks
//      oris    r4,r4,0x0010            // SDRAM Parity (else ECC)
//      oris    r4,r4,0x0004            // SDRAM inline reads
//      ori    r4, r4, 0x06b8      // 33 MHZ - REFINT
        ori    r4, r4, 0x023C      // 100 MHZ - REFINT
        stwbrx r4,0,r6
        sync

//! ===MCCR3=== MEMORY CONTROL CONFIGURATION
//!
        lis r3, BMC_BASE// Set MCCR3 (F8)
        ori    r3,r3,0x00F8
```

```
        stwbrx r3,0,r5
        sync

        lis     r4,0x7000               // BSTOPRE_M = 7
        oris    r4,r4,0x0800            // REFREC    = 8 clocks

        stwbrx r4,0,r6
        sync

//! ===MCCR4=== MEMORY CONTROL CONFIGURATION
//!
        lis  r3, BMC_BASE// Set MCCR4 (FC)
        ori    r3,r3,0x00Fc
        stwbrx r3,0,r5
        sync

        lis     r4,0x3000               // PRETOACT = 3 clocks
        oris    r4,r4,0x0500            // ACTOPRE  = 5 clocks
//      oris    r4,r4,0x0080            // Enable 8-beat burst (32-bit bus)
//      oris    r4,r4,0x0040            // Enable Inline ECC/Parity
        oris    r4,r4,0x0010            // Registered buffers
//      oris    r4,r4,0x0000            // BSTOPRE_U = 0 (see A/N)

//      ori     r4,r4,0x8000            // Registered DIMMs
        ori     r4,r4,0x3000            // CAS Latency (CL=3)
//      ori     r4,r4,0x2000            // CAS Latency (CL=2)
        ori     r4,r4,0x0030            // ACTORW  = 3 clocks
        ori     r4,r4,0x0009            // BSTOPRE_L = 9
//      ori     r4,r4,0x0200            // Sequential wrap/4-beat burst
                                        // If in 64-bit data bus width
//      ori     r4,r4,0x0300            // Sequential wrap/8-beat burst
                                        // If in 32-bit data bus width
```

```
        stwbrx r4,0,r6
        sync

//-------MSAR1/etc.
// Set each bank to 32MB (0-1FFFFFF, 2000000-...)

        lis  r3, BMC_BASE// Set MSAR1 (80)
        ori    r3,r3,MEMSTARTADDR1
        stwbrx r3,0,r5

        lis     r4, 0x6040
        ori    r4,r4,0x2000
        stwbrx r4,0,r6

        lis  r3, BMC_BASE// Set MSAR2 (84)
        ori    r3,r3,MEMSTARTADDR2
        stwbrx r3,0,r5

        lis  r4, 0xe0c0
        ori    r4,r4,0xa080
        stwbrx r4,0,r6

        lis  r3, BMC_BASE// Set MESAR1 (88)
        ori    r3,r3,XMEMSTARTADDR1
        stwbrx r3,0,r5

        lis  r4, 0x0000
        ori    r4,r4,0x0000
        stwbrx r4,0,r6

        lis  r3, BMC_BASE// Set MESAR2 (8c)
        ori    r3,r3,XMEMSTARTADDR2
```

```
stwbrx r3,0,r5

lis  r4,0x0000
ori    r4,r4,0x0000
stwbrx r4,0,r6

lis  r3, BMC_BASE// Set MEAR1 (90)
ori    r3,r3,MEMENDADDR1
stwbrx r3,0,r5

lis  r4, 0x7f5f
ori    r4,r4,0x3f1f// ending address of bank 0 is
                                // 0x0x01FFFFFF
stwbrx r4,0,r6

lis  r3, BMC_BASE// Set MEAR2 (94)
ori    r3,r3,MEMENDADDR2
stwbrx r3,0,r5

lis  r4, 0xffdf
ori    r4,r4,0xbf9f
stwbrx r4,0,r6

lis  r3, BMC_BASE// MEEAR1 (98) =
ori    r3,r3,XMEMENDADDR1
stwbrx r3,0,r5

lis  r4, 0x0000
ori    r4,r4,0x0000
stwbrx r4,0,r6

lis  r3, BMC_BASE// MEEAR2 (9c)
```

```
        ori    r3,r3,XMEMENDADDR2
        stwbrx r3,0,r5

        lis  r4, 0x0000
        ori    r4,r4,0x0000
        stwbrx r4,0,r6


//-------ODCR

        lis  r3, BMC_BASE// Set ODCR
        ori    r3,r3,0x73
        stwbrx r3,0,r5
        sync

        lbz    r4, 3(r6)           // read current register state
        li      r4,0
//      ori     r4,r4,0x80              // PCI=20 ohm (else 40)
//      ori     r4,r4,0x40              // STD=6 ohm (else 40)

//      ori     r4,r4,0x10              // MEMCTL=40 ohm
        ori     r4,r4,0x20              // MEMCTL=20 ohm
//      ori     r4,r4,0x30              // MEMCTL= 6 ohm

        ori     r4,r4,0x04              // PCICLK=40 ohm
//      ori     r4,r4,0x08              // PCICLK=20 ohm
//      ori     r4,r4,0x0c              // PCICLK= 6 ohm
        stb    r4, 3(r6)           // New settings.

//-------ODCR
lis     r3,BMC_BASE                     // Select SDRAM clock delay register
        ori     r3,r3,0x74
```

```
        stwbrx  r3,0,r5
        sync

        lhbrx   r4,0,r6         // Get current CLKCTL
        sync
        li      r4,0x0000               // Insure SDRAM_CLK's are ON
        sthbrx  r4,0,r6

//-------MIOCR2
//-------------------------------------------------------------------------
// For the MPC8245, set register 77 to %00100000 (see Errata #15)..
        lis     r3,BMC_BASE             // Select SDRAM clock delay register
        ori     r3,r3,0x77
        stwbrx  r3,0,r5
        sync

        lbz     r4,3(r6)                // Get current register
        ori     r4,r4,0x20              // Set bits 5:4 = %10
        stb     r4,3(r6)
        sync

//-------MBEN

        lis  r3, BMC_BASE// Set MBEN (a0)
        ori    r3,r3,0xa0
        stwbrx r3,0,r5
        li      r4,0x03         // Enable bank 0 and 1 (for dual-
        stb     r4, 0(r6)       // bank SODIMMs.

//-------PGMAX
        lis  r3, BMC_BASE
        ori    r3,r3,0xa3
```

```
        stwbrx r3,0,r5
//      li     r4,0x0000              // Page Mode Off
        li     r4,0x0032              //  33 MHz - w/ROMFAL=8
//      li     r4,0x0064              //  66 MHz - w/ROMFAL=8
//      li     r4,0x0096              // 100 MHz - w/ROMFAL=8
        stb    r4, 3(r6)              // Write PGMAX (note offset)

// ===AMBOR=== Address Map B Options Register
// The memory DLL needs to be cleared/set/cleared before using memory.
// This should be done after programming registers 0x72 and 0x76 according
// to the desired DLL locking mode. See the Hardware Specifications document for
// more details on the DLL locking modes and their related graphs.

        lis     r3,BMC_BASE                    // Select AMBOR (E0)
        ori     r3,r3,0x00E0
        stwbrx  r3,0,r5
        sync

        lwbrx   r4,0,r6                // Get current bits
        andi.   r4,r4,0xFFDF
        stwbrx  r4,0,r6                // Clear DLL_RESET
        sync
        ori     r4,r4,0x0020
        stwbrx  r4,0,r6                // Set DLL_RESET
        sync
        andi.   r4,r4,0xFFDF
        stwbrx  r4,0,r6                // Clear DLL_RESET
        sync

// Wait before initialize other registers
        lis     r4,0x0001
        mtctr   r4
```

```
MPC8245X4wait200us:
        bdnz    MPC8245X4wait200us

// Set MEMGO bit

        lis  r3, BMC_BASE// MCCR1 (F0) |= PGMAX
        ori    r3,r3,0x00F0
        stwbrx r3,0,r5
        sync

        lwbrx  r4,0,r6          // old MCCR1
        lis    r0, 0x0008          // MEMGO=1
        stwbrx r4, 0, r6
        sync

// Wait again

        lis     r4, 0x0002
        ori     r4,r4,0xffff

        mtctr   r4
MPC8245X4wait8ref:
        bdnz    MPC8245X4wait8ref

// -- read EUMBBAR and store content to r9
        lis    r5, 0xfec0
        lis    r6, 0xfee0
        lis    r3, 0x8000
        ori    r3, r3, 0x0078
        stwbrx r3, 0, r5
        sync
```

```
        lwbrx  r9, 0, r6

//------ WP1_CNTL_TRIG
//  WP1_CNTL_TRIG (0xFF018) = 0x00000180
        lis    r3, 0x000f
        ori    r3, r3, 0xf018
        add    r8, r9, r3    //r8 = addr of WPl_CNTL_TRIG
        lis    r4,0x0000
        ori    r4,r4,0x0180
        stwbrx r4,0,r8

 //------ WP1_ADDR_TRIG (0xFF01C) = 0x00060000
        lis    r3, 0x000f
        ori    r3,r3,0xF01C
        add     r8,r9,r3     //r8 = addr of WP1_ADDR_TRIG
        lis    r4,0x0006 // Set to 0x60000
        ori    r4,r4,0x0000
        stwbrx r4,0,r8

 //------ WP1_CNTL_MASK (0xFF020) = 0x00000180
        lis    r3,0x000f
        ori    r3,r3,0xF020
        add     r8,r9,r3     //r8 = addr of WP1_CNTL_MASK
        lis    r4,0x0000
        ori    r4,r4,0x0180
        stwbrx r4,0,r8

 //------ WP1_ADDR_MASK (0xFF024) = 0xFFFFFFFF
        lis    r3,0x000f
        ori    r3,r3,0xF024
        add    r8,r9,r3     //r8 = addr of WP1_ADDR_MASK
        lis    r4,0xFFFF
```

```
        ori    r4,r4,0xFFFF
        stwbrx r4,0,r8

 //------ WP_CONTROL (0xFF048) = 0x000001C6 then 0x010001C6
        lis    r3,0x000f
        ori    r3,r3,0xF048
        add    r8,r9,r3     //r8 = addr of WP1_CONTROL
        lis    r4,0x0000
        ori    r4,r4,0x01C6
        stwbrx r4,0,r8
        lis    r4,0x0100               // Enable Watchpoint on
        ori    r4,r4,0x01C6            // separate write
        stwbrx r4,0,r8
        sync
        lis    r3, 0x0
        or     r3, r3, r11                  // restore MPC8245 Vendor ID
        blr

/*********************************************************
 * function: get_eumbbar
 *
 * output: r3 - content of eumbbar
 *********************************************************/
      .text
      .align 2
      .global get_eumbbar
get_eumbbar:

        lis     r4,config_addr@h
        ori     r4,r4,config_addr@l
        lwz     r4,0(r4)
```

```
lis     r3,EUMBBAR_HI
ori     r3,r3,EUMBBAR_LO
stwbrx  r3,0,r4

lis     r4,config_data@h
ori     r4,r4,config_data@l
lwz     r4,0(r4)

lwbrx   r3,0,r4

blr
```

Appendix C
PowerPC Instruction Set Listings

This appendix lists the MPC8245 microprocessor's instruction set as well as the additional PowerPC instructions not implemented in the MPC8245. Instructions are sorted by mnemonic, opcode, function, and form. Also included in this appendix is a quick reference table that contains general information, such as the architecture level, privilege level, and form, and indicates if the instruction is 64-bit and optional.

Note that split fields, that represent the concatenation of sequences from left to right, are shown in lowercase. For more information refer to Chapter 8, "Instruction Set," in *The Programming Environments Manual.*

C.1 Instructions Sorted by Mnemonic

Table C-1 lists the instructions implemented in the PowerPC architecture in alphabetical order by mnemonic.

Table C-1. Complete Instruction List Sorted by Mnemonic

Key:

Reserved bits

Instruction not implemented in the MPC8245

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
add*x*	31		D					A					B					OE					266					Rc
addc*x*	31		D					A					B					OE					10					Rc
adde*x*	31		D					A					B					OE					138					Rc
addi	14		D					A					SIMM															
addic	12		D					A					SIMM															
addic.	13		D					A					SIMM															
addis	15		D					A					SIMM															
addme*x*	31		D					A					0 0 0 0 0					OE					234					Rc
addze*x*	31		D					A					0 0 0 0 0					OE					202					Rc
and*x*	31		S					A					B										28					Rc
andc*x*	31		S					A					B										60					Rc

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
andi.	28	S						A					UIMM															
andis.	29	S						A					UIMM															
b*x*	18	LI																									AA	LK
bc*x*	16	BO						BI					BD														AA	LK
bcctr*x*	19	BO						BI					0 0 0 0 0					528										LK
bclr*x*	19	BO						BI					0 0 0 0 0					16										LK
cmp	31	crfD			0	L		A					B					0										0
cmpi	11	crfD			0	L		A					SIMM															
cmpl	31	crfD			0	L		A					B					32										0
cmpli	10	crfD			0	L		A					UIMM															
cntlzd*x* [4]	31	S						A					0 0 0 0 0					58										Rc
cntlzw*x*	31	S						A					0 0 0 0 0					26										Rc
crand	19	crbD						crbA					crbB					257										0
crandc	19	crbD						crbA					crbB					129										0
creqv	19	crbD						crbA					crbB					289										0
crnand	19	crbD						crbA					crbB					225										0
crnor	19	crbD						crbA					crbB					33										0
cror	19	crbD						crbA					crbB					449										0
crorc	19	crbD						crbA					crbB					417										0
crxor	19	crbD						crbA					crbB					193										0
dcbf	31	0 0 0 0 0						A					B					86										0
dcbi [1]	31	0 0 0 0 0						A					B					470										0
dcbst	31	0 0 0 0 0						A					B					54										0
dcbt	31	0 0 0 0 0						A					B					278										0
dcbtst	31	0 0 0 0 0						A					B					246										0
dcbz	31	0 0 0 0 0						A					B					1014										0
divd*x* [4]	31	D						A					B					OE	489									Rc
divdu*x* [4]	31	D						A					B					OE	457									Rc
divwx	31	D						A					B					OE	491									Rc
divwux	31	D						A					B					OE	459									Rc
eciwx	31	D						A					B					310										0
ecowx	31	S						A					B					438										0

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
eieio	31		0	0	0	0	0		0	0	0	0	0		0	0	0	0	0		8	5	4					0
eqvx	31		S						A				B					2	8	4								Rc
extsbx	31		S						A				0	0	0	0	0	9	5	4								Rc
extshx	31		S						A				0	0	0	0	0	9	2	2								Rc
extswx [4]	31		S						A				0	0	0	0	0	9	8	6								Rc
fabsx [7]	63		D						0	0	0	0	0		B			2	6	4								Rc
faddx	63		D						A				B					0	0	0	0	0		2	1			Rc
faddsx [7]	59		D						A				B					0	0	0	0	0		2	1			Rc
fcfidx [4,7]	63		D						0	0	0	0	0		B			8	4	6								Rc
fcmpo [7]	63		crfD			0	0		A				B					3	2									0
fcmpu [7]	63		crfD			0	0		A				B					0										0
fctidx [4,7]	63		D						0	0	0	0	0		B			8	1	4								Rc
fctidzx [4,7]	63		D						0	0	0	0	0		B			8	1	5								Rc
fctiwx [7]	63		D						0	0	0	0	0		B			1	4									Rc
fctiwzx [7]	63		D						0	0	0	0	0		B			1	5									Rc
fdivx [7]	63		D						A				B					0	0	0	0	0		1	8			Rc
fdivsx [7]	59		D						A				B					0	0	0	0	0		1	8			Rc
fmaddx [7]	63		D						A				B					C					2	9				Rc
fmaddsx [7]	59		D						A				B					C					2	9				Rc
fmrx [7]	63		D						0	0	0	0	0		B			7	2									Rc
fmsubx [7]	63		D						A				B					C					2	8				Rc
fmsubsx [7]	59		D						A				B					C					2	8				Rc
fmulx [7]	63		D						A				0	0	0	0	0	C					2	5				Rc
fmulsx [7]	59		D						A				0	0	0	0	0	C					2	5				Rc
fnabsx [7]	63		D						0	0	0	0	0		B			1	3	6								Rc
fnegx [7]	63		D						0	0	0	0	0		B			4	0									Rc
fnmaddx [7]	63		D						A				B					C					3	1				Rc
fnmaddsx [7]	59		D						A				B					C					3	1				Rc
fnmsubx [7]	63		D						A				B					C					3	0				Rc
fnmsubsx [7]	59		D						A				B					C					3	0				Rc
fresx [5,7]	59		D						0	0	0	0	0		B			0	0	0	0	0		2	4			Rc
frspx [7]	63		D						0	0	0	0	0		B			1	2									Rc

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25	26 27 28 29 30	31
frsqrte*x* [5,7]	63	D	0 0 0 0 0	B	0 0 0 0 0	26	Rc
fselx [5,7]	63	D	A	B	C	23	Rc
fsqrtx [5,7]	63	D	0 0 0 0 0	B	0 0 0 0 0	22	Rc
fsqrts*x* [5,7]	59	D	0 0 0 0 0	B	0 0 0 0 0	22	Rc
fsubx [7]	63	D	A	B	0 0 0 0 0	20	Rc
fsubsx [7]	59	D	A	B	0 0 0 0 0	20	Rc
icbi	31	0 0 0 0 0	A	B	982		0
isync	19	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	150		0
lbz	34	D	A	d			
lbzu	35	D	A	d			
lbzux	31	D	A	B	119		0
lbzx	31	D	A	B	87		0
ld [4]	58	D	A	ds			0
ldarx [4]	31	D	A	B	84		0
ldu [4]	58	D	A	ds			1
ldux [4]	31	D	A	B	53		0
ldx [4]	31	D	A	B	21		0
lfd [7]	50	D	A	d			
lfdu [7]	51	D	A	d			
lfdux [7]	31	D	A	B	631		0
lfdx [7]	31	D	A	B	599		0
lfs [7]	48	D	A	d			
lfsu [7]	49	D	A	d			
lfsux [7]	31	D	A	B	567		0
lfsx [7]	31	D	A	B	535		0
lha	42	D	A	d			
lhau	43	D	A	d			
lhaux	31	D	A	B	375		0
lhax	31	D	A	B	343		0
lhbrx	31	D	A	B	790		0
lhz	40	D	A	d			
lhzu	41	D	A	d			

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
lhzux	31		D					A					B					311										0
lhzx	31		D					A					B					279										0
lmw [3]	46		D					A					d															
lswi [3]	31		D					A					NB					597										0
lswx [3]	31		D					A					B					533										0
lwa [4]	58		D					A					ds														2	
lwarx	31		D					A					B					20										0
lwaux [4]	31		D					A					B					373										0
lwax [4]	31		D					A					B					341										0
lwbrx	31		D					A					B					534										0
lwz	32		D					A					d															
lwzu	33		D					A					d															
lwzux	31		D					A					B					55										0
lwzx	31		D					A					B					23										0
mcrf	19		crfD			0	0	crfS				0	0	0	0	0	0	0										0
mcrfs [7]	63		crfD			0	0	crfS				0	0	0	0	0	0	0										0
mcrxr	31		crfD			0	0	0	0	0	0	0	0	0	0	0	0	0										0
mfcr	31		D					0	0	0	0	0	0	0	0	0	0	0										0
mffsx [7]	63		D					0	0	0	0	0	0	0	0	0	0	0										Rc
mfmsr [1]	31		D					0	0	0	0	0	0	0	0	0	0	0										0
mfspr [2]	31		D					spr																				0
mfsr [1]	31		D					0	SR				0	0	0	0	0	0										0
mfsrin [1]	31		D					0	0	0	0	0	B															0
mftb	31		D					tbr																				0
mtcrf	31		S					0	CRM								0											0
mtfsb0x [7]	63		crbD					0	0	0	0	0	0	0	0	0	0	0										Rc
mtfsb1x [7]	63		crbD					0	0	0	0	0	0	0	0	0	0	0										Rc
mtfsfx [7]	63		0	FM								0	B															Rc
mtfsfix [7]	63		crfD			0	0	0	0	0	0	0	IMM				0											Rc
mtmsr [1]	31		S					0	0	0	0	0	0	0	0	0	0	0										0
mtspr [2]	31		S					spr																				0
mtsr [1]	31		S					0	SR				0	0	0	0	0	0										0

Name	0 5	6 7 8	9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
mtsrin [1]	31	S	0 0 0 0 0	B	242		0
mulhd*x* [4]	31	D	A	B	0	73	Rc
mulhdu*x* [4]	31	D	A	B	0	9	Rc
mulhwx	31	D	A	B	0	75	Rc
mulhwux	31	D	A	B	0	11	Rc
mulld*x* [4]	31	D	A	B	OE	233	Rc
mulli	7	D	A	SIMM			
mullwx	31	D	A	B	OE	235	Rc
nandx	31	S	A	B	476		Rc
negx	31	D	A	0 0 0 0 0	OE	104	Rc
norx	31	S	A	B	124		Rc
orx	31	S	A	B	444		Rc
orcx	31	S	A	B	412		Rc
ori	24	S	A	UIMM			
oris	25	S	A	UIMM			
rfi [1]	19	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	50		0
rldcl*x* [4]	30	S	A	B	mb	8	Rc
rldcr*x* [4]	30	S	A	B	me	9	Rc
rldic*x* [4]	30	S	A	sh	mb	2 sh	Rc
rldicl*x* [4]	30	S	A	sh	mb	0 sh	Rc
rldicr*x* [4]	30	S	A	sh	me	1 sh	Rc
rldimi*x* [4]	30	S	A	sh	mb	3 sh	Rc
rlwimix	20	S	A	SH	MB	ME	Rc
rlwinmx	21	S	A	SH	MB	ME	Rc
rlwnmx	23	S	A	B	MB	ME	Rc
sc	17	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0			1 0
slbia [1,4,5]	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	498		0
slbie [1,4,5]	31	0 0 0 0 0	0 0 0 0 0	B	434		0
sldx [4]	31	S	A	B	27		Rc
slwx	31	S	A	B	24		Rc
sradx [4]	31	S	A	B	794		Rc
sradix [4]	31	S	A	sh	413	sh	Rc

Name	0 5	6 7 8	9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
srawx	31	S	A	B	792		Rc
srawix	31	S	A	SH	824		Rc
srdx [4]	31	S	A	B	539		Rc
srwx	31	S	A	B	536		Rc
stb	38	S	A	d			
stbu	39	S	A	d			
stbux	31	S	A	B	247		0
stbx	31	S	A	B	215		0
std [4]	62	S	A	ds			0
stdcx. [4]	31	S	A	B	214		1
stdu [4]	62	S	A	ds			1
stdux [4]	31	S	A	B	181		0
stdx [4]	31	S	A	B	149		0
stfd	54	S	A	d			
stfdu	55	S	A	d			
stfdux	31	S	A	B	759		0
stfdx	31	S	A	B	727		0
stfiwx [5]	31	S	A	B	983		0
stfs	52	S	A	d			
stfsu	53	S	A	d			
stfsux	31	S	A	B	695		0
stfsx	31	S	A	B	663		0
sth	44	S	A	d			
sthbrx	31	S	A	B	918		0
sthu	45	S	A	d			
sthux	31	S	A	B	439		0
sthx	31	S	A	B	407		0
stmw [3]	47	S	A	d			
stswi [3]	31	S	A	NB	725		0
stswx [3]	31	S	A	B	661		0
stw	36	S	A	d			
stwbrx	31	S	A	B	662		0

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25	26 27 28 29 30	31
stwcx.	31	S	A	B	150		1
stwu	37	S	A	d			
stwux	31	S	A	B	183		0
stwx	31	S	A	B	151		0
subfx	31	D	A	B	OE	40	Rc
subfcx	31	D	A	B	OE	8	Rc
subfex	31	D	A	B	OE	136	Rc
subfic	08	D	A	SIMM			
subfmex	31	D	A	0 0 0 0 0	OE	232	Rc
subfzex	31	D	A	0 0 0 0 0	OE	200	Rc
sync	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	598		0
td [4]	31	TO	A	B	68		0
tdi [4]	02	TO	A	SIMM			
tlbia [1,5]	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	370		0
tlbie [1,5]	31	0 0 0 0 0	0 0 0 0 0	B	306		0
tlbld [1,6]	31	0 0 0 0 0	0 0 0 0 0	B	978		0
tlbli [1,6]	31	0 0 0 0 0	0 0 0 0 0	B	1010		0
tlbsync[1,5]	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	566		0
tw	31	TO	A	B	4		0
twi	03	TO	A	SIMM			
xorx	31	S	A	B	316		Rc
xori	26	S	A	UIMM			
xoris	27	S	A	UIMM			

[1] Supervisor-level instruction
[2] Supervisor- and user-level instruction
[3] Load and store string or multiple instruction
[4] 64-bit instruction
[5] Optional in the PowerPC architecture
[6] Implementation-specific instruction

C.2 Instructions Sorted by Opcode

Table C-2 lists the instructions defined in the PowerPC architecture in numeric order by opcode.

Key:

Reserved bits

Instruction not implemented in the MPC8245

Table C-2. Complete Instruction List Sorted by Opcode

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
tdi [4]	0 0 0 0 1 0	TO						A					SIMM															
twi	0 0 0 0 1 1	TO						A					SIMM															
mulli	0 0 0 1 1 1	D						A					SIMM															
subfic	0 0 1 0 0 0	D						A					SIMM															
cmpli	0 0 1 0 1 0	crfD			0	L		A					UIMM															
cmpi	0 0 1 0 1 1	crfD			0	L		A					SIMM															
addic	0 0 1 1 0 0	D						A					SIMM															
addic.	0 0 1 1 0 1	D						A					SIMM															
addi	0 0 1 1 1 0	D						A					SIMM															
addis	0 0 1 1 1 1	D						A					SIMM															
bc*x*	0 1 0 0 0 0	BO						BI					BD													AA	LK	
sc	0 1 0 0 0 1	0 0 0 0 0						0 0 0 0 0					0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0													1	0	
b*x*	0 1 0 0 1 0	LI																								AA	LK	
mcrf	0 1 0 0 1 1	crfD			0 0			crfS			0 0		0 0 0 0 0					0 0 0 0 0 0 0 0 0 0										0
bclr*x*	0 1 0 0 1 1	BO						BI					0 0 0 0 0					0 0 0 0 0 1 0 0 0 0										LK
crnor	0 1 0 0 1 1	crbD						crbA					crbB					0 0 0 0 1 0 0 0 0 1										0
rfi	0 1 0 0 1 1	0 0 0 0 0						0 0 0 0 0					0 0 0 0 0					0 0 0 0 1 1 0 0 1 0										0
crandc	0 1 0 0 1 1	crbD						crbA					crbB					0 0 1 0 0 0 0 0 0 1										0
isync	0 1 0 0 1 1	0 0 0 0 0						0 0 0 0 0					0 0 0 0 0					0 0 1 0 0 1 0 1 1 0										0
crxor	0 1 0 0 1 1	crbD						crbA					crbB					0 0 1 1 0 0 0 0 0 1										0
crnand	0 1 0 0 1 1	crbD						crbA					crbB					0 0 1 1 1 0 0 0 0 1										0
crand	0 1 0 0 1 1	crbD						crbA					crbB					0 1 0 0 0 0 0 0 0 1										0

Name	0 5	6 7 8	9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25	26 27 28 29 30	31
creqv	0 1 0 0 1 1	crbD		crbA	crbB	0 1 0 0 1 0 0 0 0 1		0
crorc	0 1 0 0 1 1	crbD		crbA	crbB	0 1 1 0 1 0 0 0 0 1		0
cror	0 1 0 0 1 1	crbD		crbA	crbB	0 1 1 1 0 0 0 0 0 1		0
bcctr*x*	0 1 0 0 1 1	BO		BI	0 0 0 0 0	1 0 0 0 0 1 0 0 0 0		LK
rlwimi*x*	0 1 0 1 0 0	S		A	SH	MB	ME	Rc
rlwinm*x*	0 1 0 1 0 1	S		A	SH	MB	ME	Rc
rlwnm*x*	0 1 0 1 1 1	S		A	B	MB	ME	Rc
ori	0 1 1 0 0 0	S		A	UIMM			
oris	0 1 1 0 0 1	S		A	UIMM			
xori	0 1 1 0 1 0	S		A	UIMM			
xoris	0 1 1 0 1 1	S		A	UIMM			
andi.	0 1 1 1 0 0	S		A	UIMM			
andis.	0 1 1 1 0 1	S		A	UIMM			
rldicl*x* [4]	0 1 1 1 1 0	S		A	sh	mb	0 0 0 sh	Rc
rldicr*x* [4]	0 1 1 1 1 0	S		A	sh	me	0 0 1 sh	Rc
rldic*x* [4]	0 1 1 1 1 0	S		A	sh	mb	0 1 0 sh	Rc
rldimi*x* [4]	0 1 1 1 1 0	S		A	sh	mb	0 1 1 sh	Rc
rldcl*x* [4]	0 1 1 1 1 0	S		A	B	mb	0 1 0 0 0	Rc
rldcr*x* [4]	0 1 1 1 1 0	S		A	B	me	0 1 0 0 1	Rc
cmp	0 1 1 1 1 1	crfD	0 L	A	B	0 0 0 0 0 0 0 0 0 0		0
tw	0 1 1 1 1 1	TO		A	B	0 0 0 0 0 0 0 1 0 0		0
subfc*x*	0 1 1 1 1 1	D		A	B	OE	0 0 0 0 0 0 1 0 0 0	Rc
mulhdu*x* [4]	0 1 1 1 1 1	D		A	B	0	0 0 0 0 0 0 1 0 0 1	Rc
addc*x*	0 1 1 1 1 1	D		A	B	OE	0 0 0 0 0 0 1 0 1 0	Rc
mulhwu*x*	0 1 1 1 1 1	D		A	B	0	0 0 0 0 0 0 1 0 1 1	Rc
mfcr	0 1 1 1 1 1	D		0 0 0 0 0	0 0 0 0 0	0 0 0 0 0 1 0 0 1 1		0
lwarx	0 1 1 1 1 1	D		A	B	0 0 0 0 0 1 0 1 0 0		0
ldx [4]	0 1 1 1 1 1	D		A	B	0 0 0 0 0 1 0 1 0 1		0
lwzx	0 1 1 1 1 1	D		A	B	0 0 0 0 0 1 0 1 1 1		0
slw*x*	0 1 1 1 1 1	S		A	B	0 0 0 0 0 1 1 0 0 0		Rc
cntlzw*x*	0 1 1 1 1 1	S		A	0 0 0 0 0	0 0 0 0 0 1 1 0 1 0		Rc
sld*x* [4]	0 1 1 1 1 1	S		A	B	0 0 0 0 0 1 1 0 1 1		Rc

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
and*x*	0 1 1 1 1 1	S	A	B	0 0 0 0 0 1 1 1 0 0	Rc
cmpl	0 1 1 1 1 1	crfD 0 L	A	B	0 0 0 0 1 0 0 0 0 0	0
subf*x*	0 1 1 1 1 1	D	A	B	OE 0 0 0 0 1 0 1 0 0 0	Rc
ldux [4]	0 1 1 1 1 1	D	A	B	0 0 0 0 1 1 0 1 0 1	0
dcbst	0 1 1 1 1 1	0 0 0 0 0	A	B	0 0 0 0 1 1 0 1 1 0	0
lwzu*x*	0 1 1 1 1 1	D	A	B	0 0 0 0 1 1 0 1 1 1	0
cntlzd*x* [4]	0 1 1 1 1 1	S	A	0 0 0 0 0	0 0 0 0 1 1 1 0 1 0	Rc
andc*x*	0 1 1 1 1 1	S	A	B	0 0 0 0 1 1 1 1 0 0	Rc
td [4]	0 1 1 1 1 1	TO	A	B	0 0 0 1 0 0 0 1 0 0	0
mulhd*x* [4]	0 1 1 1 1 1	D	A	B	0 0 0 1 0 0 1 0 0 1	Rc
mulhw*x*	0 1 1 1 1 1	D	A	B	0 0 0 1 0 0 1 0 1 1	Rc
mfmsr	0 1 1 1 1 1	D	0 0 0 0 0	0 0 0 0 0	0 0 0 1 0 1 0 0 1 1	0
ldarx [4]	0 1 1 1 1 1	D	A	B	0 0 0 1 0 1 0 1 0 0	0
dcbf	0 1 1 1 1 1	0 0 0 0 0	A	B	0 0 0 1 0 1 0 1 1 0	0
lbzx	0 1 1 1 1 1	D	A	B	0 0 0 1 0 1 0 1 1 1	0
neg*x*	0 1 1 1 1 1	D	A	0 0 0 0 0	OE 0 0 0 1 1 0 1 0 0 0	Rc
lbzu*x*	0 1 1 1 1 1	D	A	B	0 0 0 1 1 1 0 1 1 1	0
nor*x*	0 1 1 1 1 1	S	A	B	0 0 0 1 1 1 1 1 0 0	Rc
subfe*x*	0 1 1 1 1 1	D	A	B	OE 0 0 1 0 0 0 1 0 0 0	Rc
adde*x*	0 1 1 1 1 1	D	A	B	OE 0 0 1 0 0 0 1 0 1 0	Rc
mtcrf	0 1 1 1 1 1	S	0 CRM	0	0 0 1 0 0 1 0 0 0 0	0
mtmsr	0 1 1 1 1 1	S	0 0 0 0 0	0 0 0 0 0	0 0 1 0 0 1 0 0 1 0	0
stdx [4]	0 1 1 1 1 1	S	A	B	0 0 1 0 0 1 0 1 0 1	0
stwcx.	0 1 1 1 1 1	S	A	B	0 0 1 0 0 1 0 1 1 0	1
stwx	0 1 1 1 1 1	S	A	B	0 0 1 0 0 1 0 1 1 1	0
stdux [4]	0 1 1 1 1 1	S	A	B	0 0 1 0 1 1 0 1 0 1	0
stwux	0 1 1 1 1 1	S	A	B	0 0 1 0 1 1 0 1 1 1	0
subfze*x*	0 1 1 1 1 1	D	A	0 0 0 0 0	OE 0 0 1 1 0 0 1 0 0 0	Rc
addze*x*	0 1 1 1 1 1	D	A	0 0 0 0 0	OE 0 0 1 1 0 0 1 0 1 0	Rc
mtsr	0 1 1 1 1 1	S	0 SR	0 0 0 0 0	0 0 1 1 0 1 0 0 1 0	0
stdcx. [4]	0 1 1 1 1 1	S	A	B	0 0 1 1 0 1 0 1 1 0	1
stbx	0 1 1 1 1 1	S	A	B	0 0 1 1 0 1 0 1 1 1	0

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21	22 23 24 25 26 27 28 29 30	31
subfme*x*	0 1 1 1 1 1	D	A	0 0 0 0 0	OE	0 0 1 1 1 0 1 0 0 0	Rc
mulld [4]	0 1 1 1 1 1	D	A	B	OE	0 0 1 1 1 0 1 0 0 1	Rc
addme*x*	0 1 1 1 1 1	D	A	0 0 0 0 0	OE	0 0 1 1 1 0 1 0 1 0	Rc
mullw*x*	0 1 1 1 1 1	D	A	B	OE	0 0 1 1 1 0 1 0 1 1	Rc
mtsrin	0 1 1 1 1 1	S	0 0 0 0 0	B	0 0 1 1 1 1 0 0 1 0		0
dcbtst	0 1 1 1 1 1	0 0 0 0 0	A	B	0 0 1 1 1 1 0 1 1 0		0
stbux	0 1 1 1 1 1	S	A	B	0 0 1 1 1 1 0 1 1 1		0
add*x*	0 1 1 1 1 1	D	A	B	OE	0 1 0 0 0 0 1 0 1 0	Rc
dcbt	0 1 1 1 1 1	0 0 0 0 0	A	B	0 1 0 0 0 1 0 1 1 0		0
lhzx	0 1 1 1 1 1	D	A	B	0 1 0 0 0 1 0 1 1 1		0
eqv*x*	0 1 1 1 1 1	S	A	B	0 1 0 0 0 1 1 1 0 0		Rc
tlbie [1,5]	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	B	0 1 0 0 1 1 0 0 1 0		0
eciwx	0 1 1 1 1 1	D	A	B	0 1 0 0 1 1 0 1 1 0		0
lhzux	0 1 1 1 1 1	D	A	B	0 1 0 0 1 1 0 1 1 1		0
xor*x*	0 1 1 1 1 1	S	A	B	0 1 0 0 1 1 1 1 0 0		Rc
mfspr [2]	0 1 1 1 1 1	D	spr		0 1 0 1 0 1 0 0 1 1		0
lwax [4]	0 1 1 1 1 1	D	A	B	0 1 0 1 0 1 0 1 0 1		0
lhax	0 1 1 1 1 1	D	A	B	0 1 0 1 0 1 0 1 1 1		0
tlbia [1,5]	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	0 1 0 1 1 1 0 0 1 0		0
mftb	0 1 1 1 1 1	D	tbr		0 1 0 1 1 1 0 0 1 1		0
lwaux [4]	0 1 1 1 1 1	D	A	B	0 1 0 1 1 1 0 1 0 1		0
lhaux	0 1 1 1 1 1	D	A	B	0 1 0 1 1 1 0 1 1 1		0
sthx	0 1 1 1 1 1	S	A	B	0 1 1 0 0 1 0 1 1 1		0
orc*x*	0 1 1 1 1 1	S	A	B	0 1 1 0 0 1 1 1 0 0		Rc
sradi*x* [4]	0 1 1 1 1 1	S	A	sh	1 1 0 0 1 1 1 0 1 1	sh	Rc
slbie [1,4,5]	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	B	0 1 1 0 1 1 0 0 1 0		0
ecowx	0 1 1 1 1 1	S	A	B	0 1 1 0 1 1 0 1 1 0		0
sthux	0 1 1 1 1 1	S	A	B	0 1 1 0 1 1 0 1 1 1		0
or*x*	0 1 1 1 1 1	S	A	B	0 1 1 0 1 1 1 1 0 0		Rc
divdu*x* [4]	0 1 1 1 1 1	D	A	B	OE	0 1 1 1 0 0 1 0 0 1	Rc
divwu*x*	0 1 1 1 1 1	D	A	B	OE	0 1 1 1 0 0 1 0 1 1	Rc
mtspr [2]	0 1 1 1 1 1	S	spr		0 1 1 1 0 1 0 0 1 1		0

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
dcbi	0 1 1 1 1 1	0 0 0 0 0	A	B	0 1 1 1 0 1 0 1 1 0	0
nand*x*	0 1 1 1 1 1	S	A	B	0 1 1 1 0 1 1 1 0 0	Rc
divd*x* [4]	0 1 1 1 1 1	D	A	B	OE 0 1 1 1 1 0 1 0 0 1	Rc
divw*x*	0 1 1 1 1 1	D	A	B	OE 0 1 1 1 1 0 1 0 1 1	Rc
slbia [1,4,5]	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	0 1 1 1 1 1 0 0 1 0	0
mcrxr	0 1 1 1 1 1	crfD 0 0	0 0 0 0 0	0 0 0 0 0	1 0 0 0 0 0 0 0 0 0	0
lswx [3]	0 1 1 1 1 1	D	A	B	1 0 0 0 0 1 0 1 0 1	0
lwbrx	0 1 1 1 1 1	D	A	B	1 0 0 0 0 1 0 1 1 0	0
lfsx[7]	0 1 1 1 1 1	D	A	B	1 0 0 0 0 1 0 1 1 1	0
srw*x*	0 1 1 1 1 1	S	A	B	1 0 0 0 0 1 1 0 0 0	Rc
srd*x*[4]	0 1 1 1 1 1	S	A	B	1 0 0 0 0 1 1 0 1 1	Rc
tlbsync [1,5]	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	1 0 0 0 1 1 0 1 1 0	0
lfsux[7]	0 1 1 1 1 1	D	A	B	1 0 0 0 1 1 0 1 1 1	0
mfsr	0 1 1 1 1 1	D	0 SR	0 0 0 0 0	1 0 0 1 0 1 0 0 1 1	0
lswi [3]	0 1 1 1 1 1	D	A	NB	1 0 0 1 0 1 0 1 0 1	0
sync	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	1 0 0 1 0 1 0 1 1 0	0
lfdx[7]	0 1 1 1 1 1	D	A	B	1 0 0 1 0 1 0 1 1 1	0
lfdux[7]	0 1 1 1 1 1	D	A	B	1 0 0 1 1 1 0 1 1 1	0
mfsrin [1]	0 1 1 1 1 1	D	0 0 0 0 0	B	1 0 1 0 0 1 0 0 1 1	0
stswx [3]	0 1 1 1 1 1	S	A	B	1 0 1 0 0 1 0 1 0 1	0
stwbrx	0 1 1 1 1 1	S	A	B	1 0 1 0 0 1 0 1 1 0	0
stfsx	0 1 1 1 1 1	S	A	B	1 0 1 0 0 1 0 1 1 1	0
stfsux	0 1 1 1 1 1	S	A	B	1 0 1 0 1 1 0 1 1 1	0
stswi [3]	0 1 1 1 1 1	S	A	NB	1 0 1 1 0 1 0 1 0 1	0
stfdx[7]	0 1 1 1 1 1	S	A	B	1 0 1 1 0 1 0 1 1 1	0
stfdux[7]	0 1 1 1 1 1	S	A	B	1 0 1 1 1 1 0 1 1 1	0
lhbrx	0 1 1 1 1 1	D	A	B	1 1 0 0 0 1 0 1 1 0	0
sraw*x*	0 1 1 1 1 1	S	A	B	1 1 0 0 0 1 1 0 0 0	Rc
srad*x* [4]	0 1 1 1 1 1	S	A	B	1 1 0 0 0 1 1 0 1 0	Rc
srawi*x*	0 1 1 1 1 1	S	A	SH	1 1 0 0 1 1 1 0 0 0	Rc
eieio	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	1 1 0 1 0 1 0 1 1 0	0
sthbrx	0 1 1 1 1 1	S	A	B	1 1 1 0 0 1 0 1 1 0	0

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
extsh*x*	0 1 1 1 1 1	S	A	0 0 0 0 0	1 1 1 0 0 1 1 0 1 0	Rc
extsb*x*	0 1 1 1 1 1	S	A	0 0 0 0 0	1 1 1 0 1 1 1 0 1 0	Rc
tlbld [1,6]	0 1 1 1 1 1	0 0 0 0 0	0 0 0 0 0	B	1 1 1 1 0 1 0 0 1 0	0
icbi	0 1 1 1 1 1	0 0 0 0 0	A	B	1 1 1 1 0 1 0 1 1 0	0
stfiwx [5]	0 1 1 1 1 1	S	A	B	1 1 1 1 0 1 0 1 1 1	0
extsw [4]	0 1 1 1 1 1	S	A	0 0 0 0 0	1 1 1 1 0 1 1 0 1 0	Rc
dcbz	0 1 1 1 1 1	0 0 0 0 0	A	B	1 1 1 1 1 1 0 1 1 0	0
lwz	1 0 0 0 0 0	D	A	d		
lwzu	1 0 0 0 0 1	D	A	d		
lbz	1 0 0 0 1 0	D	A	d		
lbzu	1 0 0 0 1 1	D	A	d		
stw	1 0 0 1 0 0	S	A	d		
stwu	1 0 0 1 0 1	S	A	d		
stb	1 0 0 1 1 0	S	A	d		
stbu	1 0 0 1 1 1	S	A	d		
lhz	1 0 1 0 0 0	D	A	d		
lhzu	1 0 1 0 0 1	D	A	d		
lha	1 0 1 0 1 0	D	A	d		
lhau	1 0 1 0 1 1	D	A	d		
sth	1 0 1 1 0 0	S	A	d		
sthu	1 0 1 1 0 1	S	A	d		
lmw [3]	1 0 1 1 1 0	D	A	d		
stmw [3]	1 0 1 1 1 1	S	A	d		
lfs[7]	1 1 0 0 0 0	D	A	d		
lfsu[7]	1 1 0 0 0 1	D	A	d		
lfd[7]	1 1 0 0 1 0	D	A	d		
lfdu[7]	1 1 0 0 1 1	D	A	d		
stfs[7]	1 1 0 1 0 0	S	A	d		
stfsu[7]	1 1 0 1 0 1	S	A	d		
stfd[7]	1 1 0 1 1 0	S	A	d		
stfdu[7]	1 1 0 1 1 1	S	A	d		
ld [4]	1 1 1 0 1 0	D	A	ds		0 0

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25	26 27 28 29 30	31
ldu [4]	1 1 1 0 1 0	D	A	ds			0 1
lwa [4]	1 1 1 0 1 0	D	A	ds			1 0
fdivs*x*	1 1 1 0 1 1	D	A	B	0 0 0 0 0	1 0 0 1 0	Rc
fsubs*x*	1 1 1 0 1 1	D	A	B	0 0 0 0 0	1 0 1 0 0	Rc
fadds*x*	1 1 1 0 1 1	D	A	B	0 0 0 0 0	1 0 1 0 1	Rc
fsqrts*x* [5,7]	1 1 1 0 1 1	D	0 0 0 0 0	B	0 0 0 0 0	1 0 1 1 0	Rc
fres*x* [5,7]	1 1 1 0 1 1	D	0 0 0 0 0	B	0 0 0 0 0	1 1 0 0 0	Rc
fmuls*x*	1 1 1 0 1 1	D	A	0 0 0 0 0	C	1 1 0 0 1	Rc
fmsubs*x* [7]	1 1 1 0 1 1	D	A	B	C	1 1 1 0 0	Rc
fmadds*x* [7]	1 1 1 0 1 1	D	A	B	C	1 1 1 0 1	Rc
fnmsubs*x*	1 1 1 0 1 1	D	A	B	C	1 1 1 1 0	Rc
fnmadds*x*	1 1 1 0 1 1	D	A	B	C	1 1 1 1 1	Rc
std [4]	1 1 1 1 1 0	S	A	ds			0 0
stdu [4]	1 1 1 1 1 0	S	A	ds			0 1
fcmpu [7]	1 1 1 1 1 1	crfD 0 0	A	B	0 0 0 0 0 0 0 0 0 0		0
frsp*x*	1 1 1 1 1 1	D	0 0 0 0 0	B	0 0 0 0 0 0 1 1 0 0		Rc
fctiw*x*	1 1 1 1 1 1	D	0 0 0 0 0	B	0 0 0 0 0 0 1 1 1 0		
fctiwz*x*	1 1 1 1 1 1	D	0 0 0 0 0	B	0 0 0 0 0 0 1 1 1 1		Rc
fdiv*x*	1 1 1 1 1 1	D	A	B	0 0 0 0 0	1 0 0 1 0	Rc
fsub*x*	1 1 1 1 1 1	D	A	B	0 0 0 0 0	1 0 1 0 0	Rc
fadd*x*	1 1 1 1 1 1	D	A	B	0 0 0 0 0	1 0 1 0 1	Rc
fsqrt*x* [5,7]	1 1 1 1 1 1	D	0 0 0 0 0	B	0 0 0 0 0	1 0 1 1 0	Rc
fsel*x* [5,7]	1 1 1 1 1 1	D	A	B	C	1 0 1 1 1	Rc
fmul*x*	1 1 1 1 1 1	D	A	0 0 0 0 0	C	1 1 0 0 1	Rc
frsqrte*x* [5,7]	1 1 1 1 1 1	D	0 0 0 0 0	B	0 0 0 0 0	1 1 0 1 0	Rc
fmsub*x*	1 1 1 1 1 1	D	A	B	C	1 1 1 0 0	Rc
fmadd*x*	1 1 1 1 1 1	D	A	B	C	1 1 1 0 1	Rc
fnmsub*x*	1 1 1 1 1 1	D	A	B	C	1 1 1 1 0	Rc
fnmadd*x* [7]	1 1 1 1 1 1	D	A	B	C	1 1 1 1 1	Rc
fcmpo [7]	1 1 1 1 1 1	crfD 0 0	A	B	0 0 0 0 1 0 0 0 0 0		0
mtfsb1*x*	1 1 1 1 1 1	crbD	0 0 0 0 0	0 0 0 0 0	0 0 0 0 1 0 0 1 1 0		Rc
fneg*x*	1 1 1 1 1 1	D	0 0 0 0 0	B	0 0 0 0 1 0 1 0 0 0		Rc

Name	0 5	6 7 8	9 10	11 12 13 14	15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
mcrfs[7]	1 1 1 1 1 1	crfD	0 0	crfS	0 0	0 0 0 0 0	0 0 0 1 0 0 0 0 0 0	0
mtfsb0*x*	1 1 1 1 1 1	crbD		0 0 0 0 0		0 0 0 0 0	0 0 0 1 0 0 0 1 1 0	Rc
fmr*x*	1 1 1 1 1 1	D		0 0 0 0 0		B	0 0 0 1 0 0 1 0 0 0	Rc
mtfsfi*x*	1 1 1 1 1 1	crfD	0 0	0 0 0 0 0		IMM 0	0 0 1 0 0 0 0 1 1 0	Rc
fnabs*x*	1 1 1 1 1 1	D		0 0 0 0 0		B	0 0 1 0 0 0 1 0 0 0	Rc
fabs*x*	1 1 1 1 1 1	D		0 0 0 0 0		B	0 1 0 0 0 0 1 0 0 0	Rc
mffs*x*	1 1 1 1 1 1	D		0 0 0 0 0		0 0 0 0 0	1 0 0 1 0 0 0 1 1 1	Rc
mtfsf*x*	1 1 1 1 1 1	0	FM		0	B	1 0 1 1 0 0 0 1 1 1	Rc
fctid*x* [4,7]	1 1 1 1 1 1	D		0 0 0 0 0		B	1 1 0 0 1 0 1 1 1 0	Rc
fctidz*x* [4,7]	1 1 1 1 1 1	D		0 0 0 0 0		B	1 1 0 0 1 0 1 1 1 1	Rc
fcfid*x* [4,7]	1 1 1 1 1 1	D		0 0 0 0 0		B	1 1 0 1 0 0 1 1 1 0	Rc

[1] Supervisor-level instruction
[2] Supervisor- and user-level instruction
[3] Load and store string or multiple instruction
[4] 64-bit instruction
[5] Optional in the PowerPC architecture
[6] MPC8245-implementation specific instruction

C.3 Instructions Grouped by Functional Categories

Table C-3 through Table C-30 list the PowerPC instructions grouped by function.

Key:

Reserved bits

Instruction not implemented in the MPC8245

Table C-3. Integer Arithmetic Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21	22 23 24 25 26 27 28 29 30	31
add*x*	31	D	A	B	OE	266	Rc
addc*x*	31	D	A	B	OE	10	Rc
adde*x*	31	D	A	B	OE	138	Rc
addi	14	D	A	SIMM			
addic	12	D	A	SIMM			
addic.	13	D	A	SIMM			
addis	15	D	A	SIMM			
addme*x*	31	D	A	0 0 0 0 0	OE	234	Rc
addze*x*	31	D	A	0 0 0 0 0	OE	202	Rc
divd*x* [4]	31	D	A	B	OE	489	Rc
divdu*x* [4]	31	D	A	B	OE	457	Rc
divw*x*	31	D	A	B	OE	491	Rc
divwu*x*	31	D	A	B	OE	459	Rc
mulhd*x* [4]	31	D	A	B	0	73	Rc
mulhdu*x* [4]	31	D	A	B	0	9	Rc
mulhw*x*	31	D	A	B	0	75	Rc
mulhwu*x*	31	D	A	B	0	11	Rc
mulld [4]	31	D	A	B	OE	233	Rc
mulli	07	D	A	SIMM			
mullw*x*	31	D	A	B	OE	235	Rc
neg*x*	31	D	A	0 0 0 0 0	OE	104	Rc
subf*x*	31	D	A	B	OE	40	Rc
subfc*x*	31	D	A	B	OE	8	Rc

Table C-3. Integer Arithmetic Instructions (continued)

	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21	22 23 24 25 26 27 28 29 30	31
subfic*x*	08	D	A	SIMM			
subfe*x*	31	D	A	B	OE	136	Rc
subfme*x*	31	D	A	0 0 0 0 0	OE	232	Rc
subfze*x*	31	D	A	0 0 0 0 0	OE	200	Rc

Table C-4. Integer Compare Instructions

Name	0 5	6 7 8	9	10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
cmp	31	crfD	0	L	A	B	0 0 0 0 0 0 0 0 0 0	0
cmpi	11	crfD	0	L	A	SIMM		
cmpl	31	crfD	0	L	A	B	32	0
cmpli	10	crfD	0	L	A	UIMM		

Table C-5. Integer Logical Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30	31
and*x*	31	S	A	B	28	Rc
andc*x*	31	S	A	B	60	Rc
andi.	28	S	A	UIMM		
andis.	29	S	A	UIMM		
cntlzd*x* [4]	31	S	A	0 0 0 0 0	58	Rc
cntlzw*x*	31	S	A	0 0 0 0 0	26	Rc
eqv*x*	31	S	A	B	284	Rc
extsb*x*	31	S	A	0 0 0 0 0	954	Rc
extsh*x*	31	S	A	0 0 0 0 0	922	Rc
extsw*x* [4]	31	S	A	0 0 0 0 0	986	Rc
nand*x*	31	S	A	B	476	Rc
nor*x*	31	S	A	B	124	Rc
or*x*	31	S	A	B	444	Rc
orc*x*	31	S	A	B	412	Rc
ori	24	S	A	UIMM		
oris	25	S	A	UIMM		
xor*x*	31	S	A	B	316	Rc
xori	26	S	A	UIMM		
xoris	27	S	A	UIMM		

Table C-6. Integer Rotate Instructions

Name	0–5	6–7	8–9	10–11	12–13	14–15	16–17	18–19	20–21	22–23	24–25	26–27	28–29	30	31
rldcl*x* [4]	30	S		A		B		mb			8				Rc
rldcr*x* [4]	30	S		A		B		me			9				Rc
rldic*x* [4]	30	S		A		sh		mb			2			sh	Rc
rldicl*x* [4]	30	S		A		sh		mb			0			sh	Rc
rldicr*x* [4]	30	S		A		sh		me			1			sh	Rc
rldimi*x* [4]	30	S		A		sh		mb			3			sh	Rc
rlwimi*x*	22	S		A		SH		MB			ME				Rc
rlwinm*x*	20	S		A		SH		MB			ME				Rc
rlwnm*x*	21	S		A		SH		MB			ME				Rc

Table C-7. Integer Shift Instructions

Name	0–5	6–7	8–9	10–11	12–13	14–15	16–17	18–19	20–21	22–23	24–25	26–27	28–29	30	31
sld*x* [4]	31	S		A		B		27							Rc
slw*x*	31	S		A		B		24							Rc
srad*x* [4]	31	S		A		B		794							Rc
sradi*x* [4]	31	S		A		sh		413						sh	Rc
sraw*x*	31	S		A		B		792							Rc
srawi*x*	31	S		A		SH		824							Rc
srd*x* [4]	31	S		A		B		539							Rc
srw*x*	31	S		A		B		536							Rc

Table C-8. Floating-Point Arithmetic Instructions

Name	0–5	6–7	8–9	10–11	12–13	14–15	16–17	18–19	20–21	22–23	24–25	26–27	28–29	30	31
fadd*x*	63	D		A		B		0 0 0 0 0			21				Rc
fadds*x*	59	D		A		B		0 0 0 0 0			21				Rc
fdivx	63	D		A		B		0 0 0 0 0			18				Rc
fdivsx	59	D		A		B		0 0 0 0 0			18				Rc
fmul*x*	63	D		A		0 0 0 0 0		C			25				Rc
fmu*ls**x*	59	D		A		0 0 0 0 0		C			25				Rc
fres*x* [5]	59	D		0 0 0 0 0		B		0 0 0 0 0			24				Rc
frsqrte*x* [5]	63	D		0 0 0 0 0		B		0 0 0 0 0			26				Rc
fsub*x*	63	D		A		B		0 0 0 0 0			20				Rc
fsubs*x*	59	D		A		B		0 0 0 0 0			20				Rc

Table C-8. Floating-Point Arithmetic Instructions (continued)

Name	0–5	6–10	11–15	16–20	21–25	26–30	31
fsel*x* [5]	63	D	A	B	C	23	Rc
fsqrt*x* [5]	63	D	0 0 0 0 0	B	0 0 0 0 0	22	Rc
fsqrts*x* [5]	59	D	0 0 0 0 0	B	0 0 0 0 0	22	Rc

Table C-9. Floating-Point Multiply-Add Instructions

Name	0–5	6–10	11–15	16–20	21–25	26–30	31
fmadd*x*	63	D	A	B	C	29	Rc
fmadds*x*	59	D	A	B	C	29	Rc
fmsub*x*	63	D	A	B	C	28	Rc
fmsubs*x*	59	D	A	B	C	28	Rc
fnmadd*x*	63	D	A	B	C	31	Rc
fnmadds*x*	59	D	A	B	C	31	Rc
fnmsub*x*	63	D	A	B	C	30	Rc
fnmsubs*x*	59	D	A	B	C	30	Rc

Table C-10. Floating-Point Rounding and Conversion Instructions

Name	0–5	6–10	11–15	16–20	21–25	26–30	31
fcfid*x* [4]	63	D	0 0 0 0 0	B	846		Rc
fctid*x* [4]	63	D	0 0 0 0 0	B	814		Rc
fctidz*x* [4]	63	D	0 0 0 0 0	B	815		Rc
fctiw*x*	63	D	0 0 0 0 0	B	14		Rc
fctiwz*x*	63	D	0 0 0 0 0	B	15		Rc
frsp*x*	63	D	0 0 0 0 0	B	12		Rc

Table C-11. Floating-Point Compare Instructions

Name	0–5	6–8	9–10	11–15	16–20	21–25	26–30	31
fcmpo	63	crfD	0 0	A	B	32		0
fcmpu	63	crfD	0 0	A	B	0		0

Table C-12. Floating-Point Status and Control Register Instructions

Name	0–5	6–8	9–10	11–15	16–20	21–25	26–30	31
mcrfs	63	crfD	0 0	crfS	0 0	0 0 0 0 0	64	0
mffs*x*	63	D		0 0 0 0 0		0 0 0 0 0	583	Rc
mtfsb0*x*	63	crbD		0 0 0 0 0		0 0 0 0 0	70	Rc
mtfsb1*x*	63	crbD		0 0 0 0 0		0 0 0 0 0	38	Rc
mtfsf*x*	31	0	FM		0	B	711	Rc

Table C-12. Floating-Point Status and Control Register Instructions (continued)

mtfsfi*x*	63	crfD	0 0	0 0 0 0 0	IMM	0	134	Rc

Table C-13. Integer Load Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
lbz	34		D					A					d															
lbzu	35		D					A					d															
lbzux	31		D					A					B					119										0
lbzx	31		D					A					B					87										0
ld [4]	58		D					A					ds															0
ldu [4]	58		D					A					ds															1
ldux [4]	31		D					A					B					53										0
ldx [4]	31		D					A					B					21										0
lha	42		D					A					d															
lhau	43		D					A					d															
lhaux	31		D					A					B					375										0
lhax	31		D					A					B					343										0
lhz	40		D					A					d															
lhzu	41		D					A					d															
lhzux	31		D					A					B					311										0
lhzx	31		D					A					B					279										0
lwa [4]	58		D					A					ds															2
lwaux [4]	31		D					A					B					373										0
lwax [4]	31		D					A					B					341										0
lwz	32		D					A					d															
lwzu	33		D					A					d															
lwzux	31		D					A					B					55										0
lwzx	31		D					A					B					23										0

Table C-14. Integer Store Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
stb	38		S					A					d															
stbu	39		S					A					d															
stbux	31		S					A					B					247										0
stbx	31		S					A					B					215										0

Table C-14. Integer Store Instructions (continued)

	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
std [4]	62	S						A					ds															0
stdu [4]	62	S						A					ds															1
stdux [4]	31	S						A					B					181										0
stdx [4]	31	S						A					B					149										0
sth	44	S						A					d															
sthu	45	S						A					d															
sthux	31	S						A					B					439										0
sthx	31	S						A					B					407										0
stw	36	S						A					d															
stwu	37	S						A					d															
stwux	31	S						A					B					183										0
stwx	31	S						A					B					151										0

Table C-15. Integer Load and Store with Byte-Reverse Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
lhbrx	31	D						A					B					790										0
lwbrx	31	D						A					B					534										0
sthbrx	31	S						A					B					918										0
stwbrx	31	S						A					B					662										0

Table C-16. Integer Load and Store Multiple Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
lmw [3]	46	D						A					d															
stmw [3]	47	S						A					d															

Table C-17. Integer Load and Store String Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
lswi [3]	31	D						A					NB					597										0
lswx [3]	31	D						A					B					533										0
stswi [3]	31	S						A					NB					725										0
stswx [3]	31	S						A					B					661										0

Table C-18. Memory Synchronization Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
eieio	31	0 0 0 0 0						0 0 0 0 0					0 0 0 0 0					854										0
isync	19	0 0 0 0 0						0 0 0 0 0					0 0 0 0 0					150										0

Table C-18. Memory Synchronization Instructions (continued)

ldarx [4]	31	D	A	B	84	0
lwarx	31	D	A	B	20	0
stdcx. [4]	31	S	A	B	214	1
stwcx.	31	S	A	B	150	1
sync	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	598	0

Table C-19. Floating-Point Load Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
lfd	50	D						A					d															
lfdu	51	D						A					d															
lfdux	31	D						A					B					631										0
lfdx	31	D						A					B					599										0
lfs	48	D						A					d															
lfsu	49	D						A					d															
lfsux	31	D						A					B					567										0
lfsx	31	D						A					B					535										0

Table C-20. Floating-Point Store Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
stfd	54	S						A					d															
stfdu	55	S						A					d															
stfdux	31	S						A					B					759										0
stfdx	31	S						A					B					727										0
stfiwx [5]	31	S						A					B					983										0
stfs	52	S						A					d															
stfsu	53	S						A					d															
stfsux	31	S						A					B					695										0
stfsx	31	S						A					B					663										0

Table C-21. Floating-Point Move Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
fabs*x*	63	D						0 0 0 0 0					B					264										Rc
fmr*x*	63	D						0 0 0 0 0					B					72										Rc
fnabs*x*	63	D						0 0 0 0 0					B					136										Rc
fneg*x*	63	D						0 0 0 0 0					B					40										Rc

Table C-22. Branch Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
b*x*	18	LI																									AA	LK
bc*x*	16	BO					BI						BD														AA	LK
bcctr*x*	19	BO					BI						0 0 0 0 0					528										LK
bclr*x*	19	BO					BI						0 0 0 0 0					16										LK

Table C-23. Condition Register Logical Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
crand	19	crbD						crbA					crbB					257										0
crandc	19	crbD						crbA					crbB					129										0
creqv	19	crbD						crbA					crbB					289										0
crnand	19	crbD						crbA					crbB					225										0
crnor	19	crbD						crbA					crbB					33										0
cror	19	crbD						crbA					crbB					449										0
crorc	19	crbD						crbA					crbB					417										0
crxor	19	crbD						crbA					crbB					193										0
mcrf	19	crfD			0 0			crfS			0 0		0 0 0 0 0					0 0 0 0 0 0 0 0 0 0										0

Table C-24. System Linkage Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
rfi [1]	19	0 0 0 0 0						0 0 0 0 0					0 0 0 0 0					50										0
sc	17	0 0 0 0 0						0 0 0 0 0					0 0 0 0 0 0 0 0 0 0 0 0 0 0 0														1	0

Table C-25. Trap Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
td [4]	31	TO						A					B					68										0
tdi [4]	03	TO						A					SIMM															
tw	31	TO						A					B					4										0
twi	03	TO						A					SIMM															

Table C-26. Processor Control Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
mcrxr	31	crfS				0 0		0 0 0 0 0					0 0 0 0 0					512										0
mfcr	31	D						0 0 0 0 0					0 0 0 0 0					19										0
mfmsr [1]	31	D						0 0 0 0 0					0 0 0 0 0					83										0

Table C-26. Processor Control Instructions (continued)

mfspr [2]	31	D	spr		339	0
mftb	31	D	tpr		371	0
mtcrf	31	S	0	CRM	0	144	0
mtmsr [1]	31	S	0 0 0 0 0	0 0 0 0 0	146	0
mtspr [2]	31	D	spr		467	0

Table C-27. Cache Management Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
dcbf	31		0	0	0	0	0		A					B					86									0
dcbi [1]	31		0	0	0	0	0		A					B					470									0
dcbst	31		0	0	0	0	0		A					B					54									0
dcbt	31		0	0	0	0	0		A					B					278									0
dcbtst	31		0	0	0	0	0		A					B					246									0
dcbz	31		0	0	0	0	0		A					B					1014									0
icbi	31		0	0	0	0	0		A					B					982									0

Table C-28. Segment Register Manipulation Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
mfsr [1]	31		D					0	SR				0	0	0	0	0		595									0
mfsrin [1]	31		D					0	0	0	0	0		B					659									0
mtsr [1]	31		S					0	SR				0	0	0	0	0		210									0
mtsrin [1]	31		S					0	0	0	0	0		B					242									0

Table C-29. Lookaside Buffer Management Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
slbia [1,4,5]	31		0	0	0	0	0		0	0	0	0	0		0	0	0	0	0		498							0
slbie [1,4,5]	31		0	0	0	0	0		0	0	0	0	0		B						434							0
tlbia [1,5]	31		0	0	0	0	0		0	0	0	0	0		0	0	0	0	0		370							0
tlbie [1,5]	31		0	0	0	0	0		0	0	0	0	0		B						306							0
tlbsync [1,5]	31		0	0	0	0	0		0	0	0	0	0		0	0	0	0	0		566							0

Table C-30. External Control Instructions

Name	0 – 5	6 – 7	8 – 9	10 – 11	12 – 13	14 – 15	16 – 17	18 – 19	20 – 21	22 – 23	24 – 25	26 – 27	28 – 29	30	31
eciwx	31	D		A		B		310							0
ecowx	31	S		A		B		438							0

[1] Supervisor-level instruction
[2] Supervisor- and user-level instruction
[3] Load and store string or multiple instruction
[4] 64-bit instruction
[5] Optional in the PowerPC architecture
[6] MPC8245-implementation specific instruction

C.4 Instructions Sorted by Form

Table C-31 through Table C-45 list the PowerPC instructions grouped by form.

Key:

Reserved bits

Instruction not implemented in the MPC8245

Table C-31. I-Form

OPCD	LI	AA	LK

Table 1:

Specific Instruction

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
b*x*	18	LI																									AA	LK

Table C-32. B-Form

OPCD	BO	BI	BD	AA	LK

Specific Instruction

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
bc*x*	16	BO					BI						BD														AA	LK

Table C-33. SC-Form

OPCD	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	1	0

Specific Instruction

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
sc	17	0 0 0 0 0					0 0 0 0 0						0 0 0 0 0 0 0 0 0 0 0 0 0 0 0														1	0

Table C-34. D-Form

OPCD	D	A	d
OPCD	D	A	SIMM
OPCD	S	A	d
OPCD	S	A	UIMM

OPCD	crfD	0	L	A	SIMM
OPCD	crfD	0	L	A	UIMM
OPCD	TO			A	SIMM

Specific Instructions

Name	0 5	6 7 8	9	10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26 27 28 29 30 31
addi	14	D			A		SIMM
addic	12	D			A		SIMM
addic.	13	D			A		SIMM
addis	15	D			A		SIMM
andi.	28	S			A		UIMM
andis.	29	S			A		UIMM
cmpi	11	crfD	0	L	A		SIMM
cmpli	10	crfD	0	L	A		UIMM
lbz	34	D			A		d
lbzu	35	D			A		d
lfd[7]	50	D			A		d
lfdu [7]	51	D			A		d
lfs[7]	48	D			A		d
lfsu[7]	49	D			A		d
lha	42	D			A		d
lhau	43	D			A		d
lhz	40	D			A		d
lhzu	41	D			A		d
lmw [3]	46	D			A		d
lwz	32	D			A		d
lwzu	33	D			A		d
mulli	7	D			A		SIMM
ori	24	S			A		UIMM
oris	25	S			A		UIMM
stb	38	S			A		d
stbu	39	S			A		d
stfd[7]	54	S			A		d
stfdu[7]	55	S			A		d

stfs[7]	52	S	A	d
stfsu[7]	53	S	A	d
sth	44	S	A	d
sthu	45	S	A	d
stmw [3]	47	S	A	d
stw	36	S	A	d
stwu	37	S	A	d
subfic	08	D	A	SIMM
tdi [4]	02	TO	A	SIMM
twi	03	TO	A	SIMM
xori	26	S	A	UIMM
xoris	27	S	A	UIMM

Table C-35. DS-Form

OPCD	D	A	ds	XO
OPCD	S	A	ds	XO

Specific Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25	26 27 28 29 30	31
ld [4]	58	D	A	ds			0
ldu [4]	58	D	A	ds			1
lwa [4]	58	D	A	ds			2
std [4]	62	S	A	ds			0
stdu [4]	62	S	A	ds			1

Table C-36. X-Form

OPCD	D	A	B	XO	0
OPCD	D	A	NB	XO	0
OPCD	D	0 0 0 0 0	B	XO	0
OPCD	D	0 0 0 0 0	0 0 0 0 0	XO	0
OPCD	D	0 SR	0 0 0 0 0	XO	0
OPCD	S	A	B	XO	Rc
OPCD	S	A	B	XO	1
OPCD	S	A	B	XO	0
OPCD	S	A	NB	XO	0
OPCD	S	A	0 0 0 0 0	XO	Rc

OPCD	S	0 0 0 0 0	B	XO	0
OPCD	S	0 0 0 0 0	0 0 0 0 0	XO	0
OPCD	S	0 SR	0 0 0 0 0	XO	0
OPCD	S	A	SH	XO	Rc
OPCD	crfD 0 L	A	B	XO	0
OPCD	crfD 0 0	A	B	XO	0
OPCD	crfD 0 0	crfS 0 0	0 0 0 0 0	XO	0
OPCD	crfD 0 0	0 0 0 0 0	0 0 0 0 0	XO	0
OPCD	crfD 0 0	0 0 0 0 0	IMM 0	XO	Rc
OPCD	TO	A	B	XO	0
OPCD	D	0 0 0 0 0	B	XO	Rc
OPCD	D	0 0 0 0 0	0 0 0 0 0	XO	Rc
OPCD	crbD	0 0 0 0 0	0 0 0 0 0	XO	Rc
OPCD	0 0 0 0 0	A	B	XO	0
OPCD	0 0 0 0 0	0 0 0 0 0	B	XO	0
OPCD	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	XO	0

Specific Instructions

and*x*	31	S	A	B	28	Rc
andc*x*	31	S	A	B	60	Rc
cmp	31	crfD 0 L	A	B	0	0
cmpl	31	crfD 0 L	A	B	32	0
cntlzd*x* [4]	31	S	A	0 0 0 0 0	58	Rc
cntlzw*x*	31	S	A	0 0 0 0 0	26	Rc
dcbf	31	0 0 0 0 0	A	B	86	0
dcbi [1]	31	0 0 0 0 0	A	B	470	0
dcbst	31	0 0 0 0 0	A	B	54	0
dcbt	31	0 0 0 0 0	A	B	278	0
dcbtst	31	0 0 0 0 0	A	B	246	0
dcbz	31	0 0 0 0 0	A	B	1014	0
eciw*x*	31	D	A	B	310	0
ecow*x*	31	S	A	B	438	0
eieio	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	854	0
eqv*x*	31	S	A	B	284	Rc

extsb*x*	31	S		A	0 0 0 0 0	954	Rc
extsh*x*	31	S		A	0 0 0 0 0	922	Rc
extsw*x* [4]	31	S		A	0 0 0 0 0	986	Rc
fabs*x*	63	D		0 0 0 0 0	B	264	Rc
fcfid*x* [4,7]	63	D		0 0 0 0 0	B	846	Rc
fcmpo [7]	63	crfD	0 0	A	B	32	0
fcmpu[7]	63	crfD	0 0	A	B	0	0
fctid*x* [4,7]	63	D		0 0 0 0 0	B	814	Rc
fctidz*x* [4,7]	63	D		0 0 0 0 0	B	815	Rc
fctiw*x*	63	D		0 0 0 0 0	B	14	Rc
fctiwZ*x*[7]	63	D		0 0 0 0 0	B	15	Rc
fmr*x*	63	D		0 0 0 0 0	B	72	Rc
fnabs*x*	63	D		0 0 0 0 0	B	136	Rc
fneg*x*	63	D		0 0 0 0 0	B	40	Rc
frsp*x*	63	D		0 0 0 0 0	B	12	Rc
icbi	31	0 0 0 0 0		A	B	982	0
lbzu*x*	31	D		A	B	119	0
lbz*x*	31	D		A	B	87	0
ldarx [4]	31	D		A	B	84	0
ldux [4]	31	D		A	B	53	0
ldx [4]	31	D		A	B	21	0
lfdu*x*[7]	31	D		A	B	631	0
lfd*x*[7]	31	D		A	B	599	0
lfsu*x*[7]	31	D		A	B	567	0
lfsx[7]	31	D		A	B	535	0
lhau*x*	31	D		A	B	375	0
lha*x*	31	D		A	B	343	0
lhbr*x*	31	D		A	B	790	0
lhzu*x*	31	D		A	B	311	0
lhz*x*	31	D		A	B	279	0
lswi [3]	31	D		A	NB	597	0
lswx [3]	31	D		A	B	533	0
lwar*x*	31	D		A	B	20	0
lwau*x* [4]	31	D		A	B	373	0

lwa*x* [4]	31	D	A	B	341	0
lwbr*x*	31	D	A	B	534	0
lwzu*x*	31	D	A	B	55	0
lwz*x*	31	D	A	B	23	0
mcrfs	63	crfD 0 0	crfS 0 0	0 0 0 0 0	64	0
mcrxr	31	crfD 0 0	0 0 0 0 0	0 0 0 0 0	512	0
mfcr	31	D	0 0 0 0 0	0 0 0 0 0	19	0
mffs*x*	63	D	0 0 0 0 0	0 0 0 0 0	583	Rc
mfmsr [1]	31	D	0 0 0 0 0	0 0 0 0 0	83	0
mfsr [1]	31	D	0 SR	0 0 0 0 0	595	0
mfsrin [1]	31	D	0 0 0 0 0	B	659	0
mtfsb0*x* [7]	63	crbD	0 0 0 0 0	0 0 0 0 0	70	Rc
mtfsb1*x* [7]	63	crfD	0 0 0 0 0	0 0 0 0 0	38	Rc
mtfsfi*x*	63	crbD 0 0	0 0 0 0 0	IMM 0	134	Rc
mtmsr [1]	31	S	0 0 0 0 0	0 0 0 0 0	146	0
mtsr [1]	31	S	0 SR	0 0 0 0 0	210	0
mtsrin [1]	31	S	0 0 0 0 0	B	242	0
nand*x*	31	S	A	B	476	Rc
nor*x*	31	S	A	B	124	Rc
or*x*	31	S	A	B	444	Rc
orc*x*	31	S	A	B	412	Rc
slbia [1,4,5]	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	498	0
slbie [1,4,5]	31	0 0 0 0 0	0 0 0 0 0	B	434	0
sld*x* [4]	31	S	A	B	27	Rc
slw*x*	31	S	A	B	24	Rc
srad*x* [4]	31	S	A	B	794	Rc
sraw*x*	31	S	A	B	792	Rc
srawi*x*	31	S	A	SH	824	Rc
srd*x* [4]	31	S	A	B	539	Rc
srw*x*	31	S	A	B	536	Rc
stbu*x*	31	S	A	B	247	0
stb*x*	31	S	A	B	215	0
stdc*x* [4]	31	S	A	B	214	1
stdu*x* [4]	31	S	A	B	181	0

std*x* [4]	31	S	A	B	149	0
stfdu*x* [7]	31	S	A	B	759	0
stfd*x* [7]	31	S	A	B	727	0
stfiw*x* [5,7]	31	S	A	B	983	0
stfsu*x* [7]	31	S	A	B	695	0
stfs*x* [7]	31	S	A	B	663	0
sthbr*x*	31	S	A	B	918	0
sthu*x*	31	S	A	B	439	0
sth*x*	31	S	A	B	407	0
stswi [3]	31	S	A	NB	725	0
stswx [3]	31	S	A	B	661	0
stwbr*x*	31	S	A	B	662	0
stwc*x*	31	S	A	B	150	1
stwu*x*	31	S	A	B	183	0
stw*x*	31	S	A	B	151	0
sync	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	598	0
td [4]	31	TO	A	B	68	0
tlbia [1,5]	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	370	0
tlbie [1,5]	31	0 0 0 0 0	0 0 0 0 0	B	306	0
tlbsync [1,5]	31	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	566	0
tw	31	TO	A	B	4	0
xor*x*	31	S	A	B	316	Rc

Table C-37. XL-Form

OPCD	BO		BI		0 0 0 0 0	XO	LK
OPCD	crbD		crbA		crbB	XO	0
OPCD	crfD	0 0	crfS	0 0	0 0 0 0 0	XO	0
OPCD	0 0 0 0 0		0 0 0 0 0		0 0 0 0 0	XO	0

Specific Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31

bcctr*x*	19	BO	BI	0 0 0 0 0	528	LK
bclr*x*	19	BO	BI	0 0 0 0 0	16	LK
crand	19	crbD	crbA	crbB	257	0
crandc	19	crbD	crbA	crbB	129	0

creqv	19	crbD	crbA	crbB	289	0
crnand	19	crbD	crbA	crbB	225	0
crnor	19	crbD	crbA	crbB	33	0
cror	19	crbD	crbA	crbB	449	0
crorc	19	crbD	crbA	crbB	417	0
crxor	19	crbD	crbA	crbB	193	0
isync	19	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	150	0
mcrf	19	crfD 0 0	crfS 0 0	0 0 0 0 0	0	0
rfi [1]	19	0 0 0 0 0	0 0 0 0 0	0 0 0 0 0	50	0

Table C-38. XFX-Form

OPCD	D	spr		XO	0
OPCD	D	0	CRM 0	XO	0
OPCD	S	spr		XO	0
OPCD	D	tbr		XO	0

Specific Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	
mfspr [2]	31	D						spr										339											0
mftb	31	D						tbr										371											0
mtcrf	31	S						0	CRM								0	144											0
mtspr [2]	31	D						spr										467											0

Table C-39. XFL-Form

OPCD	0	FM	0	B	XO	Rc

Specific Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	
mtfsf*x* [7]	63		0					FM					0					B											Rc

Table C-40. XS-Form

OPCD	S	A	sh	XO	sh	Rc

Specific Instructions

Name	0	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	
sradi*x* [4]	31		S					A					sh					413									sh		Rc

Table C-41. XO-Form

OPCD	D	A	B	OE	XO	Rc
OPCD	D	A	B	0	XO	Rc
OPCD	D	A	0 0 0 0 0	OE	XO	Rc

Specific Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21	22 23 24 25 26 27 28 29 30	31
add*x*	31	D	A	B	OE	266	Rc
addc*x*	31	D	A	B	OE	10	Rc
adde*x*	31	D	A	B	OE	138	Rc
addme*x*	31	D	A	0 0 0 0 0	OE	234	Rc
addze*x*	31	D	A	0 0 0 0 0	OE	202	Rc
divd*x* [4]	31	D	A	B	OE	489	Rc
divdu*x* [4]	31	D	A	B	OE	457	Rc
divw*x*	31	D	A	B	OE	491	Rc
divwu*x*	31	D	A	B	OE	459	Rc
mulhd*x* [4]	31	D	A	B	0	73	Rc
mulhdu*x* [4]	31	D	A	B	0	9	Rc
mulhw*x*	31	D	A	B	0	75	Rc
mulhwu*x*	31	D	A	B	0	11	Rc
mulld*x* [4]	31	D	A	B	OE	233	Rc
mullw*x*	31	D	A	B	OE	235	Rc
neg*x*	31	D	A	0 0 0 0 0	OE	104	Rc
subf*x*	31	D	A	B	OE	40	Rc
subfc*x*	31	D	A	B	OE	8	Rc
subfe*x*	31	D	A	B	OE	136	Rc
subfme*x*	31	D	A	0 0 0 0 0	OE	232	Rc
subfze*x*	31	D	A	0 0 0 0 0	OE	200	Rc

Table C-42. A-Form

OPCD	D	A	B	0 0 0 0 0	XO	Rc
OPCD	D	A	B	C	XO	Rc
OPCD	D	A	0 0 0 0 0	C	XO	Rc
OPCD	D	0 0 0 0 0	B	0 0 0 0 0	XO	Rc

Specific Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25	26 27 28 29 30	31
fadd*x*	63	D	A	B	0 0 0 0 0	21	Rc
fadds*x*	59	D	A	B	0 0 0 0 0	21	Rc
fdiv*x*	63	D	A	B	0 0 0 0 0	18	Rc
fdivs*x*	59	D	A	B	0 0 0 0 0	18	Rc
fmadd*x*	63	D	A	B	C	29	Rc
fmadds*x*	59	D	A	B	C	29	Rc
fmsub*x*	63	D	A	B	C	28	Rc
fmsubs*x*	59	D	A	B	C	28	Rc
fmul*x*	63	D	A	0 0 0 0 0	C	25	Rc
fmuls*x*	59	D	A	0 0 0 0 0	C	25	Rc
fnmadd*x* [7]	63	D	A	B	C	31	Rc
fnmadds*x*	59	D	A	B	C	31	Rc
fnmsub*x* [7]	63	D	A	B	C	30	Rc
fnmsubs*x*	59	D	A	B	C	30	Rc
fres*x* [5,7]	59	D	0 0 0 0 0	B	0 0 0 0 0	24	Rc
frsqrte*x* [5,7]	63	D	0 0 0 0 0	B	0 0 0 0 0	26	Rc
fsel*x* [5,7]	63	D	A	B	C	23	Rc
fsqrt*x* [5,7]	63	D	0 0 0 0 0	B	0 0 0 0 0	22	Rc
fsqrts*x* [5,7]	59	D	0 0 0 0 0	B	0 0 0 0 0	22	Rc
fsub*x*	63	D	A	B	0 0 0 0 0	20	Rc
fsubs*x*	59	D	A	B	0 0 0 0 0	20	Rc

Table C-43. M-Form

OPCD	S	A	SH	MB	ME	Rc
OPCD	S	A	B	MB	ME	Rc

Specific Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25	26 27 28 29 30	31
rlwimi*x*	20	S	A	SH	MB	ME	Rc
rlwinm*x*	21	S	A	SH	MB	ME	Rc
rlwnm*x*	23	S	A	B	MB	ME	Rc

Table C-44. MD-Form

OPCD	S	A	sh	mb	XO	sh	Rc
OPCD	S	A	sh	me	XO	sh	Rc

Specific Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26	27 28 29 30	31
rldic*x* [4]	30	S	A	sh	mb	2	sh	Rc
rldicl*x* [4]	30	S	A	sh	mb	0	sh	Rc
rldicr*x* [4]	30	S	A	sh	me	1	sh	Rc
rldimi*x* [4]	30	S	A	sh	mb	3	sh	Rc

Table C-45. MDS-Form

OPCD	S	A	B	mb	XO	Rc
OPCD	S	A	B	me	XO	Rc

Specific Instructions

Name	0 5	6 7 8 9 10	11 12 13 14 15	16 17 18 19 20	21 22 23 24 25 26	27 28 29 30	31
rldcl*x* [4]	30	S	A	B	mb	8	Rc
rldcr*x* [4]	30	S	A	B	me	9	Rc

[1] Supervisor-level instruction
[2] Supervisor- and user-level instruction
[3] Load and store string or multiple instruction
[4] 64-bit instruction
[5] Optional in the PowerPC architecture
[6] MPC8245-implementation specific instruction

C.5 Instruction Set Legend

Table C-46 provides general information on the PowerPC instruction set (such as the architectural level, privilege level, and form).

Key:

Reserved bits

Instruction not implemented in the MPC8245

Table C-46. PowerPC Instruction Set Legend

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
add*x*	√						XO
addc*x*	√						XO
adde*x*	√						XO
addi	√						D
addic	√						D
addic.	√						D
addis	√						D
addme*x*	√						XO
addze*x*	√						XO
and*x*	√						X
andc*x*	√						X
andi.	√						D
andis.	√						D
b*x*	√						I
bc*x*	√						B
bcctr*x*	√						XL
bclr*x*	√						XL
cmp	√						X
cmpi	√						D
cmpl	√						X
cmpli	√						D
cntlzd*x* [4]	√				√		X

Table C-46. PowerPC Instruction Set Legend (continued)

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
cntlzw*x*	√						X
crand	√						XL
crandc	√						XL
creqv	√						XL
crnand	√						XL
crnor	√						XL
cror	√						XL
crorc	√						XL
crxor	√						XL
dcbf		√					X
dcbi [1]			√	√			X
dcbst		√					X
dcbt		√					X
dcbtst		√					X
dcbz		√					X
divd*x* [4]	√				√		XO
divdu*x* [4]	√				√		XO
divw*x*	√						XO
divwu*x*	√						XO
eciw*x*		√				√	X
ecow*x*		√				√	X
eieio		√					X
eqv*x*	√						X
extsb*x*	√						X
extsh*x*	√						X
extsw*x* [4]	√				√		X
fabs*x*	√						X
fadd*x*	√						A
fadds*x*	√						A
fcfid*x* [4,7]	√				√		X
fcmpo [7]	√						X
fcmpu [7]	√						X
fctid*x* [4,7]	√				√		X

Table C-46. PowerPC Instruction Set Legend (continued)

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
fctidz*x* [7,4]	√				√		X
fctiw*x*	√						X
fctiwz*x*	√						X
fdiv*x*	√						A
fdivs*x*	√						A
fmadd*x*	√						A
fmadds*x* [7]	√						A
fmr*x*	√						X
fmsub*x*	√						A
fmsubs*x* [7]	√						A
fmul*x*	√						A
fmuls*x*	√						A
fnabs*x* [7]	√						X
fneg*x*	√						X
fnmadd*x* [7]	√						A
fnmaddS*x*	√						A
fnmsub*x*	√						A
fnmsubs*x*	√						A
fres*x* [5,7]	√					√	A
frsp*x*	√						X
frsqrte*x* [5,7]	√					√	A
fsel*x* [5,7]	√					√	A
fsqrt*x* [7]	√					√	A
fsqrts*x* [5,7]	√					√	A
fsub*x*	√						A
fsubs*x*	√						A
icbi		√					X
isync		√					XL
lbz	√						D
lbzu	√						D
lbzux	√						X
lbzx	√						X
ld [4]	√				√		DS

Table C-46. PowerPC Instruction Set Legend (continued)

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
ldar*x* [4]	√				√		X
ldu [4]	√				√		DS
ldu*x* [4]	√				√		X
ld*x* [4]	√				√		X
lfd[7]	√						D
lfdu [7]	√						D
lfdu*x*[7]	√						X
lfd*x*[7]	√						X
lfs[7]	√						D
lfsu[7]	√						D
lfsu*x*[7]	√						X
lfsx[7]	√						X
lha	√						D
lhau	√						D
lhau*x*	√						X
lha*x*	√						X
lhbr*x*	√						X
lhz	√						D
lhzu	√						D
lhzu*x*	√						X
lhz*x*	√						X
lmw [3]	√						D
lswi [3]	√						X
lsw*x* [3]	√						X
lwa [4]	√				√		DS
lwar*x*	√						X
lwau*x* [4]	√				√		X
lwax [4]	√				√		X
lwbr*x*	√						X
lwz	√						D
lwzu	√						D
lwzu*x*	√						X
lwz*x*	√						X

Table C-46. PowerPC Instruction Set Legend (continued)

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
mcrf	√						XL
mcrfs[7]	√						X
mcrxr	√						X
mfcr	√						X
mffs*x*	√						X
mfmsr [1]			√	√			X
mfspr [2]	√		√	√			XFX
mfsr [1]			√	√			X
mfsrin [1]			√	√			X
mftb		√					XFX
mtcrf	√						XFX
mtfsb0*x*	√						X
mtfsb1*x* [7]	√						X
mtfsf*x*	√						XFL
mtfsfi*x*	√						X
mtmsr [1]			√	√			X
mtspr [2]	√		√	√			XFX
mtsr [1]			√	√			X
mtsrin [1]			√	√			X
mulhd*x* [4]	√				√		XO
mulhdu*x* [4]	√				√		XO
mulhw*x*	√						XO
mulhwu*x*	√						XO
mulld*x* [4]	√				√		XO
mulli	√						D
mullw*x*	√						XO
nand*x*	√						X
neg*x*	√						XO
nor*x*	√						X
or*x*	√						X
orc*x*	√						X
ori	√						D
oris	√						D

Table C-46. PowerPC Instruction Set Legend (continued)

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
rfi [1]			√	√			XL
rldcl*x* [4]	√				√		MDS
rldcr*x* [4]	√				√		MDS
rldic*x* [4]	√				√		MD
rldicl*x* [4]	√				√		MD
rldicr*x* [4]	√				√		MD
rldimi*x* [4]	√				√		MD
rlwimi*x*	√						M
rlwinm*x*	√						M
rlwnm*x*	√						M
sc	√		√				SC
slbia [1,4,5]			√	√	√	√	X
slbie [1,4,5]			√	√	√	√	X
sld*x* [4]	√				√		X
slw*x*	√						X
srad*x* [4]	√				√		X
sradi*x* [4]	√				√		XS
sraw*x*	√						X
srawi*x*	√						X
srd*x* [4]	√				√		X
srw*x*	√						X
stb	√						D
stbu	√						D
stbu*x*	√						X
stb*x*	√						X
std [4]	√				√		DS
stdc*x***.** [4]	√				√		X
stdu [4]	√				√		DS
stdu*x* [4]	√				√		X
std*x* [4]	√				√		X
stfd[7]	√						D
stfdu[7]	√						D
stfdu*x*[7]	√						X

Table C-46. PowerPC Instruction Set Legend (continued)

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
stfd*x*[7]	√						X
stfiw*x* [5,7]	√					√	X
stfs[7]	√						D
stfsu[7]	√						D
stfsu*x*[7]	√						X
stfs*x*[7]	√						X
sth	√						D
sthbr*x*	√						X
sthu	√						D
sthu*x*	√						X
sth*x*	√						X
stmw [3]	√						D
stswi [3]	√						X
stsw*x* [3]	√						X
stw	√						D
stwbr*x*	√						X
stwc*x***.**	√						X
stwu	√						D
stwu*x*	√						X
stw*x*	√						X
subf*x*	√						XO
subfc*x*	√						XO
subfe*x*	√						XO
subfic	√						D
subfme*x*	√						XO
subfze*x*	√						XO
sync	√						X
td [4]	√				√		X
tdi [4]	√				√		D
tlbia [1,5]			√	√		√	X
tlbie [1,5]			√	√		√	X
tlbld [1,6]				√			X
tlbli [1,6]				√			X

Table C-46. PowerPC Instruction Set Legend (continued)

	UISA	VEA	OEA	Supervisor Level	64-Bit	Optional	Form
tlbsync [1,5]			√	√			X
tw	√						X
twi	√						D
xor*x*	√						X
xori	√						D
xoris	√						D

[1] Supervisor-level instruction
[2] Supervisor- and user-level instruction
[3] Load and store string or multiple instruction
[4] 64-bit instruction
[5] Optional in the PowerPC architecture
[6] MPC8245-implementation specific instruction

Appendix D
Processor Core Register Summary

This appendix summarizes the register set in the processor core of the MPC8245 as defined by the three programming environments of the PowerPC architecture—the user instruction set architecture (UISA), the virtual environment architecture (VEA), and the operating environment architecture (OEA), as well as the implementation-specific registers from the MPC603e and the MPC8245-specific registers.

The register formats and bit descriptions in this appendix are intended only as a reference. Many details important for the programming of the processor core registers, such as synchronization requirements and bit interactions, are not supplied here. Full descriptions of the basic register set defined by the PowerPC architecture are provided in Chapter 2, "PowerPC Register Set," in *The Programming Environments Manual*. Additionally, more complete descriptions of the processor core registers that are part of the MPC603e are provided in Chapter 2, "Programming Model," in the *MPC603e RISC Microprocessor User's Manual*. See those references for important details about the registers and individual bits.

D.1 PowerPC Register Set

The PowerPC architecture defines register-to-register operations for all computational instructions. Source data for these instructions is accessed from the on-chip registers or is provided as an immediate value embedded in the opcode. The three-register instruction format allows specification of a target register distinct from the two source registers, thus preserving the original data for use by other instructions and reducing the number of instructions required for certain operations. Data is transferred between memory and registers with explicit load and store instructions only.

Figure D-1 shows the complete MPC8245 register set and the programming environment to which each register belongs. This figure includes both the PowerPC register set and the MPC8245-specific registers.

Note that other registers common to other processors that implement the PowerPC architecture are not implemented in the MPC8245's processor core. Unsupported special purpose register (SPR) values are treated as follows:

- Any **mtspr** with an invalid SPR executes as a no-op.

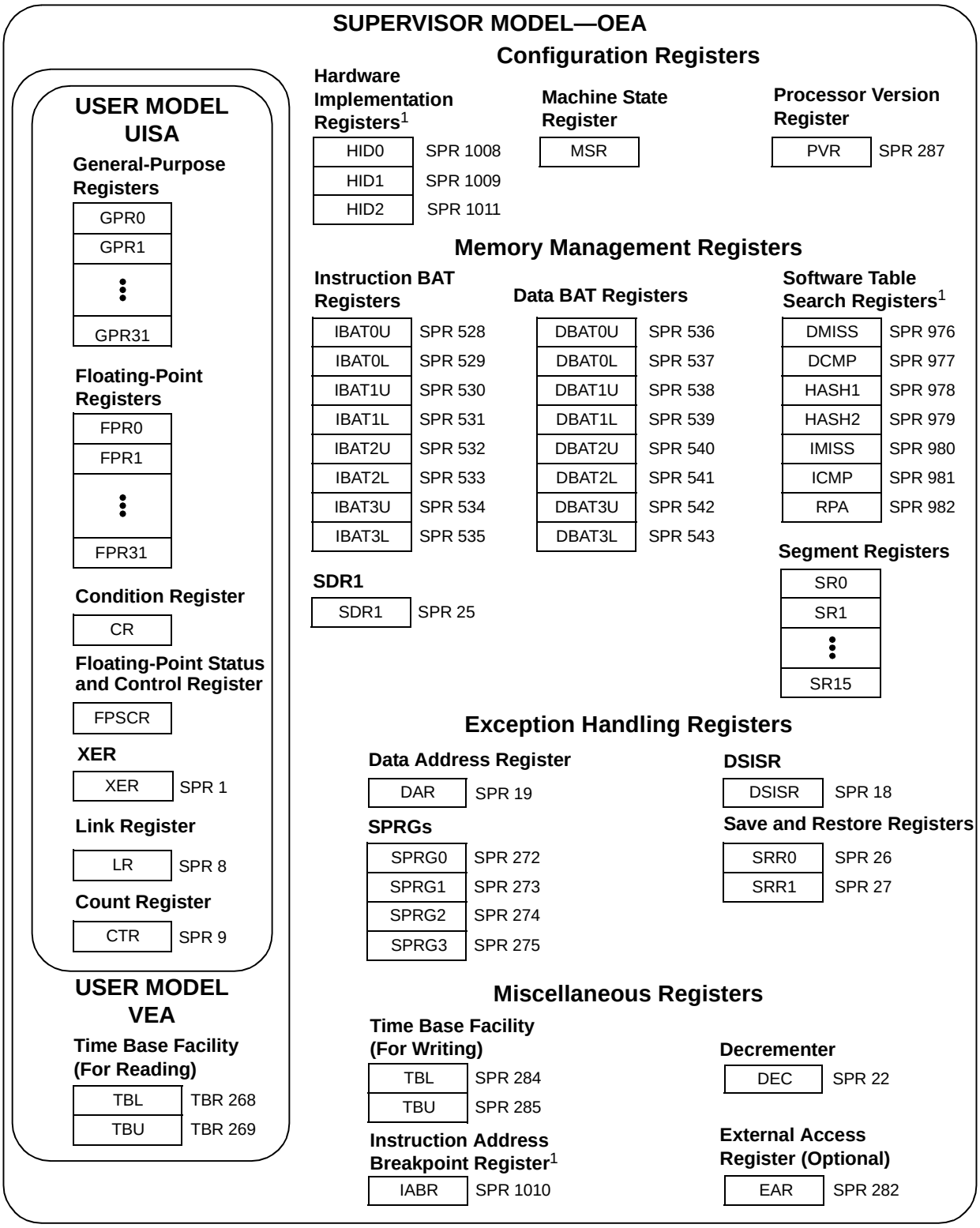
- Any **mfspr** with an invalid SPR causes boundedly undefined results in the target register.

Furthermore, some SPRs in the processor core may not be implemented at all or may not be implemented in the same way in other processors that implement the PowerPC architecture.

D.1.1 PowerPC Register Set—UISA

The PowerPC UISA registers, shown in Figure D-1, can be accessed by either user- or supervisor-level instructions. The general-purpose registers (GPRs) and floating-point registers (FPRs) are accessed through instruction operands. Access to registers can be explicit (that is, through the use of specific instructions for that purpose such as the **mtspr** and **mfspr** instructions) or implicit as part of the execution (or side effect) of an instruction. Some registers are accessed both explicitly and implicitly.

The number to the right of the register name indicates the decimal number that is used in the syntax of the instruction operands to access the register (for example, the number used to access the XER is one).



[1] These implementation–specific registers may not be supported by other PowerPC processors or processor cores.

Figure D-1. MPC8245 Processor Programming Model—Registers

D.1.1.1 General-Purpose Registers (GPRs)

Integer data is manipulated in the processor's 32 GPRs shown in Figure D-2. The GPRs are accessed as source and destination registers in the instruction syntax.

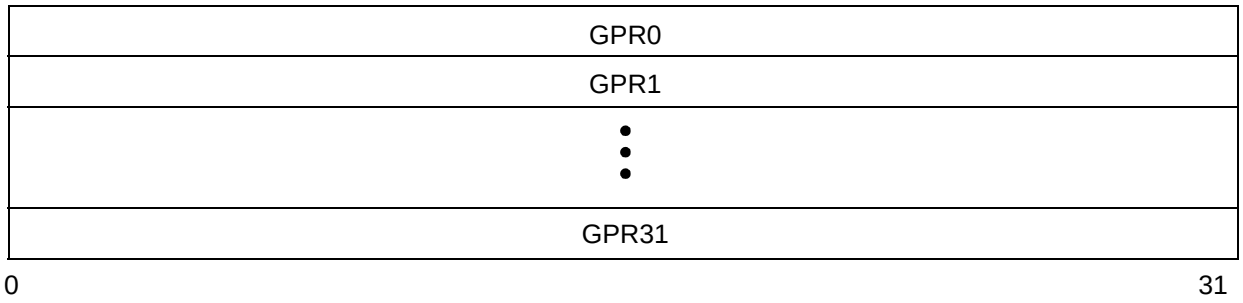


Figure D-2. General-Purpose Registers (GPRs)

D.1.1.2 Floating-Point Registers (FPRs)

The PowerPC architecture provides thirty-two 64-bit FPRs as shown in Figure D-3.

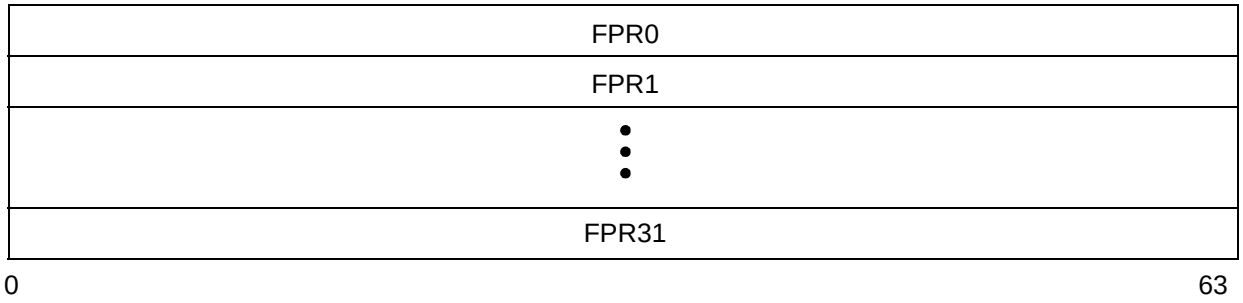


Figure D-3. Floating-Point Registers (FPRs)

D.1.1.3 Condition Register (CR)

The bits in the CR are grouped into eight 4-bit fields, CR0–CR7, as shown in Figure D-4.

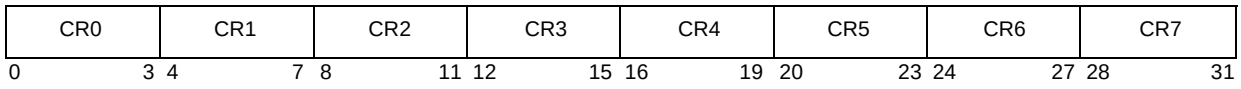


Figure D-4. Condition Register (CR)

D.1.1.3.1 Condition Register CR0 Field Definition

The CR0 bits are interpreted as shown in Table D-1.

Table D-1. Bit Settings for CR0 Field of CR

CR0 Bit	Description
0	Negative (LT)—This bit is set when the result is negative.
1	Positive (GT)—This bit is set when the result is positive (and not zero).
2	Zero (EQ)—This bit is set when the result is zero.
3	Summary overflow (SO)—This is a copy of the final state of XER[SO] at the completion of the instruction.

D.1.1.3.2 Condition Register CR1 Field Definition

The bit settings for the CR1 field are shown in Table D-2.

Table D-2. Bit Settings for CR1 Field of CR

CR1 Bit	Description
4	Floating-point exception (FX)—This is a copy of the final state of FPSCR[FX] at the completion of the instruction.
5	Floating-point enabled exception (FEX)—This is a copy of the final state of FPSCR[FEX] at the completion of the instruction.
6	Floating-point invalid exception (VX)—This is a copy of the final state of FPSCR[VX] at the completion of the instruction.
7	Floating-point overflow exception (OX)—This is a copy of the final state of FPSCR[OX] at the completion of the instruction.

D.1.1.3.3 Condition Register CR*n* Field—Compare Instruction

For a compare instruction the bits of the specified field are interpreted as shown in Table D-3.

Table D-3. CR*n* Field Bit Settings for Compare Instructions

CR*n* Bit[1]	Description
0	Less than or floating-point less than (LT, FL). For integer compare instructions: **r**A < SIMM or **r**B (signed comparison) or **r**A < UIMM or **r**B (unsigned comparison). For floating-point compare instructions: **fr**A < **fr**B.
1	Greater than or floating-point greater than (GT, FG). For integer compare instructions: **r**A > SIMM or **r**B (signed comparison) or **r**A > UIMM or **r**B (unsigned comparison). For floating-point compare instructions: **fr**A > **fr**B.
2	Equal or floating-point equal (EQ, FE). For integer compare instructions: **r**A = SIMM, UIMM, or **r**B. For floating-point compare instructions: **fr**A = **fr**B.

Table D-3. CR*n* Field Bit Settings for Compare Instructions (continued)

CR*n* Bit[1]	Description
3	Summary overflow or floating-point unordered (SO, FU). For integer compare instructions:This is a copy of the final state of XER[SO] at the completion of the instruction. For floating-point compare instructions: One or both of **fr**A and **fr**B is a Not a Number (NaN).

[1]Here, the bit indicates the bit number in any one of the 4-bit subfields, CR0–CR7.

D.1.1.4 Floating-Point Status and Control Register (FPSCR)

The FPSCR is shown in Figure D-5.

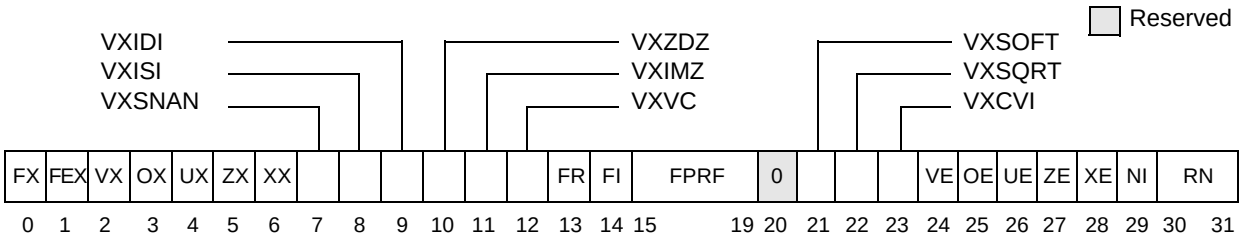


Figure D-5. Floating-Point Status and Control Register (FPSCR)

A listing of FPSCR bit settings is shown in Table D-4.

Table D-4. FPSCR Bit Settings

Bit(s)	Name	Description
0	FX	Floating-point exception summary. Every floating-point instruction, except **mtfsfi** and **mtfsf**, implicitly sets FPSCR[FX] if that instruction causes any of the floating-point exception bits in the FPSCR to transition from 0 to 1. The **mcrfs**, **mtfsfi**, **mtfsf**, **mtfsb0**, and **mtfsb1** instructions can alter FPSCR[FX] explicitly. This is a sticky bit.
1	FEX	Floating-point enabled exception summary. This bit signals the occurrence of any of the enabled exception conditions. It is the logical OR of all the floating-point exception bits masked by their respective enable bits (FEX = (VX & VE) ^ (OX & OE) ^ (UX & UE) ^ (ZX & ZE) ^ (XX & XE)). The **mcrfs**, **mtfsf**, **mtfsfi**, **mtfsb0**, and **mtfsb1** instructions cannot alter FPSCR[FEX] explicitly. This is not a sticky bit.
2	VX	Floating-point invalid operation exception summary. This bit signals the occurrence of any invalid operation exception. It is the logical OR of all of the invalid operation exceptions. The **mcrfs**, **mtfsf**, **mtfsfi**, **mtfsb0**, and **mtfsb1** instructions cannot alter FPSCR[VX] explicitly. This is not a sticky bit.
3	OX	Floating-point overflow exception. This is a sticky bit.
4	UX	Floating-point underflow exception. This is a sticky bit.
5	ZX	Floating-point zero divide exception. This is a sticky bit.

Table D-4. FPSCR Bit Settings (continued)

Bit(s)	Name	Description
6	XX	Floating-point inexact exception. This is a sticky bit. FPSCR[XX] is the sticky version of FPSCR[FI]. The following rules describe how FPSCR[XX] is set by a given instruction: • If the instruction affects FPSCR[FI], the new value of FPSCR[XX] is obtained by logically ORing the old value of FPSCR[XX] with the new value of FPSCR[FI]. • If the instruction does not affect FPSCR[FI], the value of FPSCR[XX] is unchanged.
7	VXSNAN	Floating-point invalid operation exception for SNaN. This is a sticky bit.
8	VXISI	Floating-point invalid operation exception for ∞ – ∞. This is a sticky bit.
9	VXIDI	Floating-point invalid operation exception for ∞ ÷ ∞. This is a sticky bit.
10	VXZDZ	Floating-point invalid operation exception for 0 ÷ 0. This is a sticky bit.
11	VXIMZ	Floating-point invalid operation exception for ∞ * 0. This is a sticky bit.
12	VXVC	Floating-point invalid operation exception for invalid compare. This is a sticky bit.
13	FR	Floating-point fraction rounded. The last arithmetic or rounding and conversion instruction that rounded the intermediate result incremented the fraction. This bit is not sticky.
14	FI	Floating-point fraction inexact. The last arithmetic or rounding and conversion instruction either rounded the intermediate result (producing an inexact fraction) or caused a disabled overflow exception. This is not a sticky bit. For more information regarding the relationship between FPSCR[FI] and FPSCR[XX], see the description of the FPSCR[XX] bit.
15–19	FPRF	Floating-point result flags. For arithmetic, rounding, and conversion instructions, the field is based on the result placed into the target register, except that if any portion of the result is undefined, the value placed here is undefined. 15 Floating-point result class descriptor (C). Arithmetic, rounding, and conversion instructions may set this bit with the FPCC bits to indicate the class of the result as shown in Table D-5. 16–19 Floating-point condition code (FPCC). Floating-point compare instructions always set one of the FPCC bits to one and the other three FPCC bits to zero. Arithmetic, rounding, and conversion instructions may set the FPCC bits with the C bit to indicate the class of the result. Note that in this case the high-order three bits of the FPCC retain their relational significance indicating that the value is less than, greater than, or equal to zero. 16 Floating-point less than or negative (FL or <) 17 Floating-point greater than or positive (FG or >) 18 Floating-point equal or zero (FE or =) 19 Floating-point unordered or NaN (FU or?) Note that these are not sticky bits.
20	—	Reserved
21	VXSOFT	Floating-point invalid operation exception for software request. This is a sticky bit. This bit can be altered only by the **mcrfs**, **mtfsfi**, **mtfsf**, **mtfsb0**, or **mtfsb1** instructions.
22	VXSQRT	Floating-point invalid operation exception for invalid square root. This is a sticky bit.
23	VXCVI	Floating-point invalid operation exception for invalid integer convert. This is a sticky bit.
24	VE	Floating-point invalid operation exception enable.
25	OE	IEEE floating-point overflow exception enable.
26	UE	IEEE floating-point underflow exception enable.

Table D-4. FPSCR Bit Settings (continued)

Bit(s)	Name	Description
27	ZE	IEEE floating-point zero divide exception enable.
28	XE	Floating-point inexact exception enable.
29	NI	Floating-point non-IEEE mode. If this bit is set, results need not conform with IEEE standards and the other FPSCR bits may have meanings other than those described here. If the bit is set and if all implementation-specific requirements are met and if an IEEE-conforming result of a floating-point operation would be a denormalized number, the result produced is zero (retaining the sign of the denormalized number). Any other effects associated with setting this bit are described in the user's manual for the implementation (the effects are implementation-dependent).
30–31	RN	Floating-point rounding control. 00 Round to nearest 01 Round toward zero 10 Round toward +infinity 11 Round toward –infinity

Table D-5 illustrates the floating-point result flags used by processors that implement the PowerPC architecture. The result flags correspond to FPSCR bits 15–19.

Table D-5. Floating-Point Result Flags in FPSCR

Result Flags (Bits 15–19)					Result Value Class
C	<	>	=	?	
1	0	0	0	1	Quiet NaN
0	1	0	0	1	–Infinity
0	1	0	0	0	–Normalized number
1	1	0	0	0	–Denormalized number
1	0	0	1	0	–Zero
0	0	0	1	0	+Zero
1	0	1	0	0	+Denormalized number
0	0	1	0	0	+Normalized number
0	0	1	0	1	+Infinity

D.1.1.5 XER Register (XER)

The XER register (XER) is a 32-bit, user-level register shown in Figure D-6.

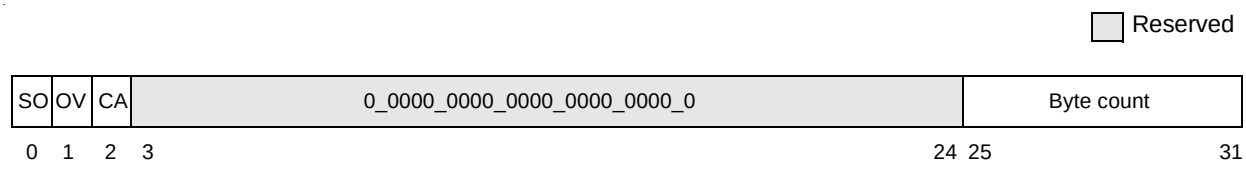


Figure D-6. XER Register

The bit definitions for XER are shown in Table D-6.

Table D-6. XER Bit Definitions

Bit(s)	Name	Description
0	SO	Summary overflow. The summary overflow bit (SO) is set whenever an instruction (except **mtspr**) sets the overflow bit (OV). When set, the SO bit remains set until it is cleared by an **mtspr** instruction (specifying the XER) or an **mcrxr** instruction. It is not altered by compare instructions, nor by other instructions (except **mtspr** to the XER, and **mcrxr**) that cannot overflow. Executing an **mtspr** instruction to the XER, supplying the values zero for SO and one for OV, causes SO to be cleared and OV to be set.
1	OV	Overflow. The overflow bit (OV) is set to indicate that an overflow has occurred during execution of an instruction. Add, subtract from, and negate instructions having OE = 1 set the OV bit if the carry out of the msb is not equal to the carry out of the msb + 1, and clear it otherwise. Multiply low and divide instructions having OE = 1 set the OV bit if the result cannot be represented in 64 bits (**mulld**, **divd**, **divdu**) or in 32 bits (**mullw**, **divw**, **divwu**), and clear it otherwise. The OV bit is not altered by compare instructions that cannot overflow (except **mtspr** to the XER, and **mcrxr**).
2	CA	Carry. The carry bit (CA) is set during execution of the following instructions: • Add carrying, subtract from carrying, add extended, and subtract from extended instructions set CA if there is a carry out of the msb, and clear it otherwise. • Shift right algebraic instructions set CA if any 1 bits have been shifted out of a negative operand, and clear it otherwise. The CA bit is not altered by compare instructions, nor by other instructions that cannot carry (except shift right algebraic, **mtspr** to the XER, and **mcrxr**).
3–24	—	Reserved
25–31		This field specifies the number of bytes to be transferred by a Load String Word Indexed (**lswx**) or Store String Word Indexed (**stswx**) instruction.

D.1.1.6 Link Register (LR)

The format of LR is shown in Figure D-7.

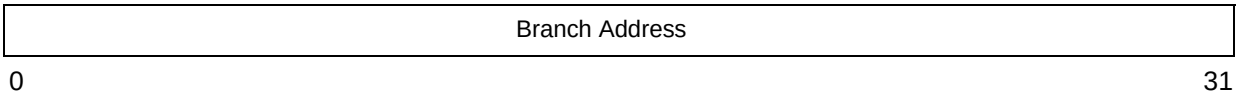


Figure D-7. Link Register (LR)

D.1.1.7 Count Register (CTR)

The CTR is shown in Figure D-8.

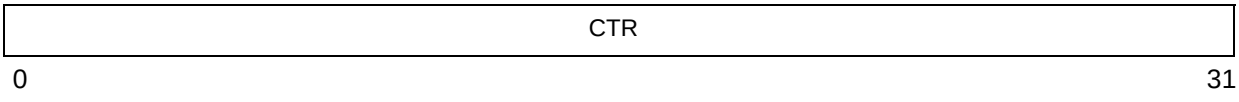


Figure D-8. Count Register (CTR)

The encoding for the BO field is shown in Table D-7.

Table D-7. BO Operand Encodings

BO	Description
0000*y*	Decrement the CTR, then branch if the decremented CTR ≠ 0 and the condition is FALSE.
0001*y*	Decrement the CTR, then branch if the decremented CTR = 0 and the condition is FALSE.
001*zy*	Branch if the condition is FALSE.
0100*y*	Decrement the CTR, then branch if the decremented CTR ≠ 0 and the condition is TRUE.
0101*y*	Decrement the CTR, then branch if the decremented CTR = 0 and the condition is TRUE.
011*zy*	Branch if the condition is TRUE.
1*z*00*y*	Decrement the CTR, then branch if the decremented CTR ≠ 0.
1*z*01*y*	Decrement the CTR, then branch if the decremented CTR = 0.
1*z*1*zz*	Branch always.

Notes: The *y* bit provides a hint about whether a conditional branch is likely to be taken and is used by some implementations of the PowerPC architecture to improve performance. Other implementations may ignore the *y* bit.

The *z* indicates a bit that is ignored. The *z* bits should be cleared (zero), as they may be assigned a meaning in a future version of the PowerPC UISA.

D.1.2 PowerPC VEA Register Set—Time Base

The PowerPC virtual environment architecture (VEA) defines registers in addition to those defined by the UISA. The PowerPC VEA register set can be accessed by all software with either user- or supervisor-level privileges. Figure D-1 provides a graphic illustration of the PowerPC VEA register set included in the MPC8245.

The PowerPC VEA introduces the time base facility (TB), a 64-bit structure that consists of two 32-bit registers—time base upper (TBU) and time base lower (TBL), whose contents are incremented once every four *sys_logic_clk* cycles on the MPC8245. Note that the time base registers can be accessed by both user- and supervisor-level instructions. In the context of the VEA, user-level applications are permitted read-only access to the TB. The OEA defines supervisor-level access to the TB for writing values to the TB. See Section D.1.3.9, “Time Base Facility (TB)—OEA; Writing to the Time Base,” for more information.

The time base (TB) is shown in Figure D-9.

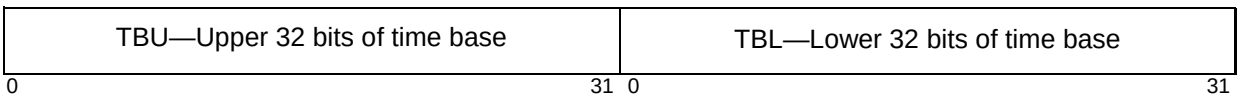


Figure D-9. Time Base (TB)

D.1.2.1 Reading the Time Base

The **mftb** instruction is used to read the time base. For information about writing the time base, see Section D.1.3.9, “Time Base Facility (TB)—OEA; Writing to the Time Base.”

On 32-bit implementations, it is not possible to read the entire 64-bit time base in a single instruction. The **mftb** simplified mnemonic moves from the lower half of the time base register (TBL) to a GPR, and the **mftbu** simplified mnemonic moves from the upper half of the time base (TBU) to a GPR.

Because of the possibility of a carry from TBL to TBU occurring between reads of the TBL and TBU, a sequence such as the following example is necessary to read the time base on 32-bit implementations:

```
loop:
        mftbu   rx      #load from TBU
        mftb    ry      #load from TBL
        mftbu   rz      #load from TBU
        cmpw    rz,rx   #see if ‘old’ = ‘new’
        bne     loop    #loop if carry occurred
```

The comparison and loop are necessary to ensure that a consistent pair of values has been obtained. The previous example will also work on 64-bit implementations running in either 64-bit or 32-bit mode.

D.1.2.2 Computing Time of Day from the Time Base

Because the update frequency of the time base is system-dependent, the algorithm for converting the current value in the time base to time of day is also system-dependent.

In a system in which the update frequency of the time base may change over time, it is not possible to convert an isolated time base value into time of day. Instead, a time base value has meaning only with respect to the current update frequency and the time of day that the update frequency was last changed. Each time the update frequency changes, either the system software is notified of the change via an exception, or else the change was instigated by the system software itself. At each such change, the system software must compute the current time of day using the old update frequency, compute a new value of ticks-per-second for the new frequency, and save the time of day, time base value, and tick rate. Subsequent calls to compute time of day use the current time base value and the saved data.

A generalized service to compute time of day could take the following as input:

- Time of day at beginning of current epoch
- Time base value at beginning of current epoch

- Time base update frequency
- Time base value for which time of day is desired

For a system in which the time base update frequency does not vary, the first three inputs would be constant.

D.1.3 PowerPC OEA Register Set

The PowerPC operating environment architecture (OEA) comprises the remaining PowerPC registers. The OEA defines the registers that are used typically by an operating system for such operations as memory management, configuration, and exception handling. Figure D-1 shows a graphic representation of the entire PowerPC register set—UISA, VEA, and OEA implemented on the MPC8245.

All of the registers in the OEA, including the SPRs, can be accessed only by supervisor-level instructions; any attempt to access supervisor SPRs with user-level instructions results in a supervisor-level exception. Some SPRs are implementation-specific.

Note that the GPRs, LR, CTR, TBL, MSR, DAR, SDR1, SRR0, SRR1, and SPRG0–SPRG3 are 32 bits wide on 32-bit implementations (like the MPC8245).

A summary of the PowerPC OEA supervisor-level registers in the MPC8245 follows:

- **Configuration registers**
  - Machine state register (MSR). The MSR defines the state of the processor. The MSR can be modified by the Move to Machine State Register (**mtmsr**), System Call (**sc)**, and Return from Interrupt (**rfi)** instructions. It can be read by the Move from Machine State Register (**mfmsr)** instruction.

    Implementation Note—The MPC603e and MPC8245 define MSR[13] as the power management enable (POW) bit and MSR[14] as the temporary GPR remapping (TGPR) bit as shown in Table D-8.
  - Processor version register (PVR). This register is a read-only register that identifies the version (model) and revision level of the processor.

    Implementation Note—The MPC8245's processor version number is 0x8081; the processor revision level starts at 0x1014 and is incremented for each revision of the chip. The revision level is updated on all silicon revisions.
- **Memory management registers**
  - Block-address translation (BAT) registers. The PowerPC OEA includes eight block-address translation registers (BATs), consisting of four pairs of instruction BATs (IBAT0U–IBAT3U and IBAT0L–IBAT3L) and four pairs of data BATs (DBAT0U–DBAT3U and DBAT0L–DBAT3L). The SPR numbers for the BAT registers are shown in Figure D-1.

  - SDR1. The SDR1 register specifies the page table base address used in virtual-to-physical address translation.
  - Segment registers (SR). The PowerPC OEA defines sixteen 32-bit segment registers (SR0–SR15). Note that the SRs are implemented on 32-bit implementations only. The fields in the segment register are interpreted differently depending on the value of bit 0.

- **Exception handling registers**
  - Data address register (DAR). After a DSI or an alignment exception, DAR is set to the effective address generated by the faulting instruction.
  - SPRG0–SPRG3. The SPRG0–SPRG3 registers are provided for operating system use.
  - DSISR. The DSISR defines the cause of DSI and alignment exceptions.
  - Machine status save/restore register 0 (SRR0). The SRR0 register is used to save machine status on exceptions and to restore machine status when an **rfi** instruction is executed.
  - Machine status save/restore register 1 (SRR1). The SRR1 register is used to save machine status on exceptions and to restore machine status when an **rfi** instruction is executed.

    Implementation Note—The MPC603e and MPC8245 implement the Key bit (bit 12) in the SRR1 register in order to simplify the table search software.

- **Miscellaneous registers**
  - The time base facility (TB) for writing. The TB is a 64-bit register pair that can be used to provide time of day or interval timing. It consists of two 32-bit registers—time base upper (TBU) and time base lower (TBL). The TB is incremented once every four *sys_logic_clk* cycles.
  - Decrementer (DEC). The DEC register is a 32-bit decrementing counter that provides a mechanism for causing a decrementer exception after a programmable delay. The DEC is decremented once every four *sys_logic_clk* cycles.
  - External access register (EAR). This optional register is used with the **eciwx** and **ecowx** instructions. While the PowerPC architecture specifies that the low-order six bits of the EAR (bits 26–31) are used to select a device, the MPC603e and MPC8245 only implement the low-order 4 bits (bits 28–31). Note that the EAR register and the **eciwx** and **ecowx** instructions are optional in the PowerPC architecture and may not be supported in all processors that implement the OEA.

D.1.3.1 Machine State Register (MSR)

The machine state register (MSR) is shown in Figure D-10.

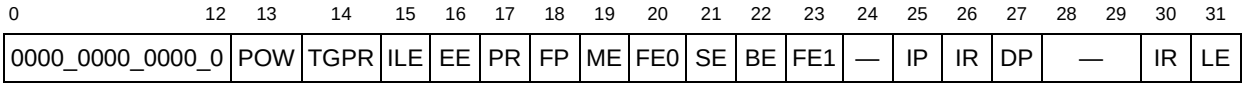


Figure D-10. Machine State Register (MSR)

Table D-8 shows the bit definitions for the MSR.

Table D-8. MSR Bit Settings

Bit(s)	Name	Reset Value	Description
0–12	—	0	Reserved
13	POW	0	Power management enable (MPC603e-specific) 0 Power management disabled (normal operation mode) 1 Power management modes enabled (doze, nap, or sleep mode) This bit controls the programmable power modes only; it has no effect on dynamic power management (DPM). MSR[POW] may be altered with an **mtmsr** instruction only. Also, when altering the POW bit, software may alter only this bit in the MSR and no others with the same instruction. The **mtmsr** instruction must be followed by a context-synchronizing instruction.
14	TGPR	0	Temporary GPR remapping (MPC603e-specific) 0 Normal operation 1 TGPR mode. GPR0–GPR3 are remapped to TGPR0–TGPR3 for use by TLB miss routines. The contents of GPR0–GPR3 remain unchanged while MSR[TGPR] = 1. Attempts to use GPR4–GPR31 with MSR[TGPR] = 1 yield undefined results. When this bit is set, all instruction accesses to GPR0–GPR3 are mapped to TGPR0–TGPR3, respectively. The TGPR bit is set when an instruction TLB miss, data TLB miss on load or data TLB miss on store exception is taken. The TGPR bit is cleared by an **rfi** instruction.
15	ILE	0	Exception little-endian mode. When an exception occurs, this bit is copied into MSR[LE] to select the endian mode for the context established by the exception.
16	EE	0	External interrupt enable 0 While the bit is cleared, the processor delays recognition of external interrupts and decrementer exception conditions. 1 The processor is enabled to take an external interrupt or the decrementer exception.
17	PR	0	Privilege level 0 The processor can execute both user- and supervisor-level instructions. 1 The processor can only execute user-level instructions.
18	FP	0	Floating-point available 0 The processor prevents dispatch of floating-point instructions, including floating-point loads, stores, and moves. 1 The processor can execute floating-point instructions.
19	ME	0	Machine check enable 0 Machine check exceptions are disabled. 1 Machine check exceptions are enabled.
20	FE0	0	Floating-point exception mode 0 (see Table D-9).

Table D-8. MSR Bit Settings (continued)

Bit(s)	Name	Reset Value	Description
21	SE	0	Single-step trace enable 0 The processor executes instructions normally. 1 The processor generates a single-step trace exception upon the successful execution of the next instruction.
22	BE	0	Branch trace enable 0 The processor executes branch instructions normally. 1 The processor generates a branch trace exception after completing the execution of a branch instruction, regardless of whether the branch was taken.
23	FE1	0	Floating-point exception mode 1 (see Table D-9).
24	—	0	Reserved
25	IP	1	Exception prefix. The setting of this bit specifies whether an exception vector offset is prepended with Fs or 0s. In the following description, *nnnnn* is the offset of the exception vector. 0 Exceptions are vectored to the physical address 0x000*n_nnnn*. 1 Exceptions are vectored to the physical address 0xFFF*n_nnnn*. In most systems, IP is set to 1 during system initialization, and then cleared to 0 when initialization is complete.
26	IR	0	Instruction address translation 0 Instruction address translation is disabled. 1 Instruction address translation is enabled.
27	DR	0	Data address translation 0 Data address translation is disabled. 1 Data address translation is enabled.
28–29	—	0	Reserved
30	RI	0	Recoverable exception (for system reset and machine check exceptions). 0 Exception is not recoverable. 1 Exception is recoverable.
31	LE	0	Little-endian mode enable 0 The processor runs in big-endian mode. 1 The processor runs in little-endian mode.

The floating-point exception mode bits (FE0–FE1) are interpreted as shown in Table D-9.

Table D-9. Floating-Point Exception Mode Bits

FE0	FE1	Mode
0	0	Floating-point exceptions disabled
0	1	Floating-point imprecise nonrecoverable
1	0	Floating-point imprecise recoverable
1	1	Floating-point precise mode

D.1.3.2 Processor Version Register (PVR)

The processor version register (PVR) is a 32-bit, read-only register that contains a value identifying the specific version (model) and revision level of the processor as shown in Figure D-11.

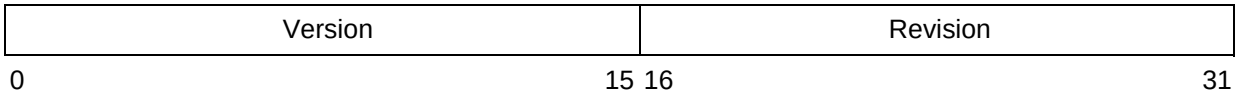


Figure D-11. Processor Version Register (PVR)

Software can identify the MPC8245 processor core by reading the processor version register (PVR). The MPC8245's processor version number is 0x8081; the processor revision level starts at 0x1014 and is incremented for each revision of the chip. This information is useful for data cache flushing routines for identifying the size of the cache and identifying this processor as one that supports cache locking.

D.1.3.3 BAT Registers

Figure D-12 and Figure D-13 show the format of the upper and lower BAT registers for 32-bit processors that implement the PowerPC architecture.

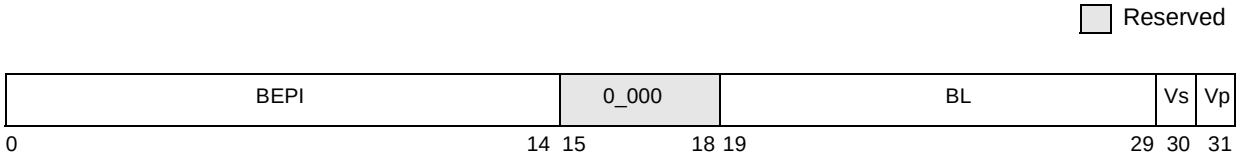
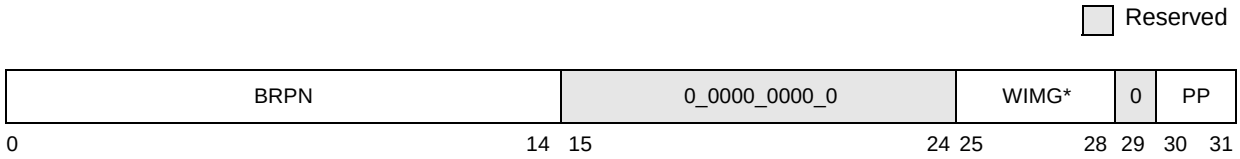


Figure D-12. Upper BAT Register



*W and G bits are not defined for IBAT registers. Attempting to write to these bits causes boundedly-undefined results.

Figure D-13. Lower BAT Register

Table D-10 describes the bits in the BAT registers.

Table D-10. BAT Registers—Field and Bit Descriptions

Upper/Lower BAT	Bits	Name	Description
Upper BAT Register	0–14	BEPI	Block effective page index. This field is compared with high-order bits of the logical address to determine if there is a hit in that BAT array entry.
	15–18	—	Reserved
	19–29	BL	Block length. BL is a mask that encodes the size of the block. Values for this field are listed in Table D-11.
	30	Vs	Supervisor mode valid bit. This bit interacts with MSR[PR] to determine if there is a match with the logical address.
	31	Vp	User mode valid bit. This bit also interacts with MSR[PR] to determine if there is a match with the logical address.
Lower BAT Register	0–14	BRPN	This field is used with the BL field to generate high-order bits of the physical address of the block.
	15–24	—	Reserved
	25–28	WIMG	Memory/cache access mode bits W Write-through I Caching-inhibited M Memory coherence G Guarded Attempting to write to the W and G bits in IBAT registers causes boundedly-undefined results.
	29	—	Reserved
	30–31	PP	Protection bits for block. This field determines the protection for the block.

Table D-11 lists the BAT area lengths encoded in BAT[BL].

Table D-11. BAT Area Lengths

BAT Area Length	BL Encoding
128 Kbytes	000 0000 0000
256 Kbytes	000 0000 0001
512 Kbytes	000 0000 0011
1 Mbyte	000 0000 0111
2 Mbytes	000 0000 1111
4 Mbytes	000 0001 1111
8 Mbytes	000 0011 1111
16 Mbytes	000 0111 1111
32 Mbytes	000 1111 1111
64 Mbytes	001 1111 1111

Table D-11. BAT Area Lengths (continued)

BAT Area Length	BL Encoding
128 Mbytes	011 1111 1111
256 Mbytes	111 1111 1111

D.1.3.4 SDR1

The format of the SDR1 is shown in Figure D-14.

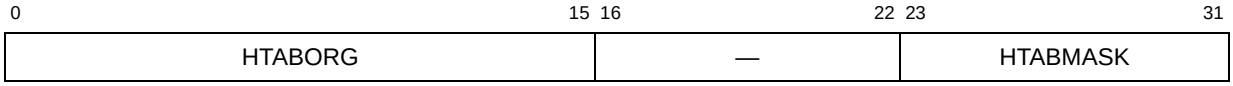


Figure D-14. SDR1 Register Format

The bits of SDR1 are described in Table D-12.

Table D-12. SDR1 Bit Settings

Bits	Name	Description
0–15	HTABORG	The high-order 16 bits of the 32-bit physical address of the page table
16–22	—	Reserved
23–31	HTABMASK	Mask for page table address

D.1.3.5 Segment Registers

The segment registers, shown in Figure D-15, contain the segment descriptors.

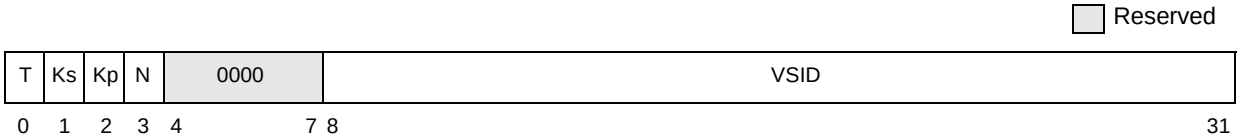


Figure D-15. Segment Register Format (T = 0)

Segment register bit settings when T = 0 are described in Table D-13.

Table D-13. Segment Register Bit Settings (T = 0)

Bits	Name	Description
0	T	T = 0 selects this format
1	Ks	Supervisor-state protection key
2	Kp	User-state protection key
3	N	No-execute protection

Table D-13. Segment Register Bit Settings (T = 0) (continued)

Bits	Name	Description
4–7	—	Reserved
8–31	VSID	Virtual segment ID

D.1.3.6 SPRG0–SPRG3

The format of SPRG0–SPRG3 is shown in Figure D-16.

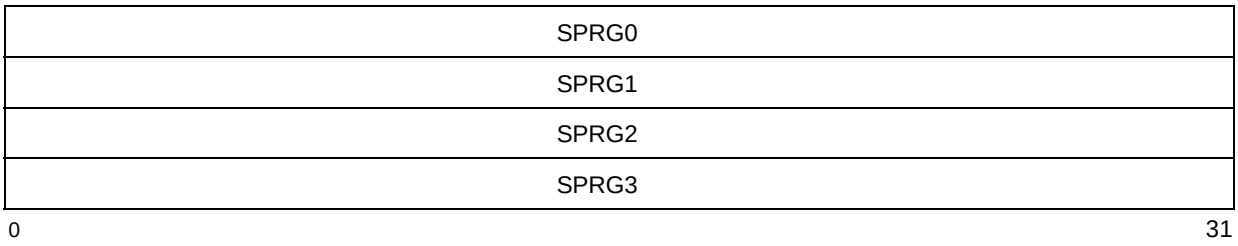


Figure D-16. SPRG0–SPRG3

Table D-14 provides a description of conventional uses of SPRG0 through SPRG3.

Table D-14. Conventional Uses of SPRG0–SPRG3

Register	Description
SPRG0	Software may load a unique physical address in this register to identify an area of memory reserved for use by the first-level exception handler. This area must be unique for each processor in the system.
SPRG1	This register may be used as a scratch register by the first-level exception handler to save the content of a GPR. That GPR then can be loaded from SPRG0 and used as a base register to save other GPRs to memory.
SPRG2	This register may be used by the operating system as needed.
SPRG3	This register may be used by the operating system as needed.

D.1.3.7 DSISR

The 32-bit DSISR is shown in Figure D-17.

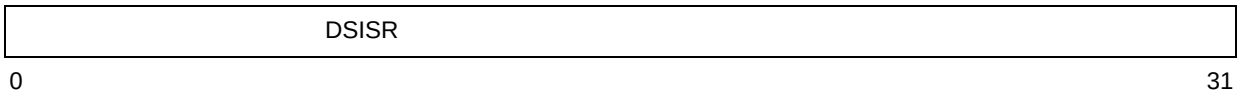


Figure D-17. DSISR

For information about bit settings, see Chapter 4, “Exceptions,” in the *MPC603e RISC Microprocessor User’s Manual.*

D.1.3.8 Machine Status Save/Restore Register 0 (SRR0)

The format of SRR0 is shown in Figure D-18.

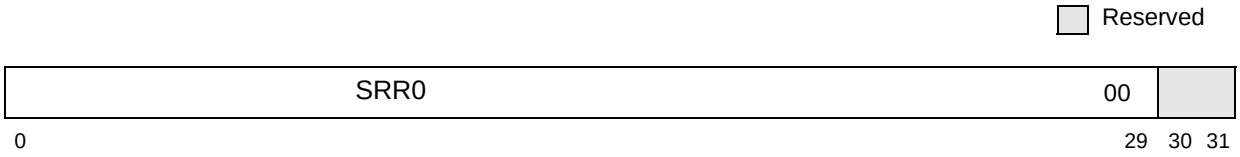


Figure D-18. Machine Status Save/Restore Register 0 (SRR0)

The format of SRR1 is shown in Figure D-19.

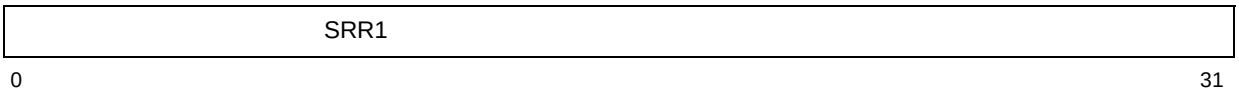


Figure D-19. Machine Status Save/Restore Register 1 (SRR1)

D.1.3.9 Time Base Facility (TB)—OEA; Writing to the Time Base

Writing to the TB is reserved for supervisor-level software.

The simplified mnemonics, **mttbl** and **mttbu**, write the lower and upper halves of the TB, respectively. The simplified mnemonics listed above are for the **mtspr** instruction. The **mtspr**, **mttbl**, and **mttbu** instructions treat TBL and TBU as separate 32-bit registers; setting one leaves the other unchanged. The entire 64-bit time base cannot be written with a single instruction.

D.1.3.10 Decrementer Register (DEC)

The decrementer register (DEC), shown in Figure D-20, is a 32-bit decrementing counter that is decremented once every four *sys_logic_clk* cycles and provides a mechanism for causing a decrementer exception after a programmable delay.

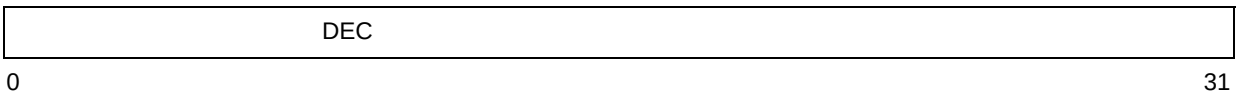


Figure D-20. Decrementer Register (DEC)

D.1.3.11 External Access Register (EAR)

The EAR is a 32-bit SPR that controls access to the external control facility and identifies the target device for external control operations. This register can also be accessed by using the **mtspr** and **mfspr** instructions. The EAR is shown in Figure D-21.

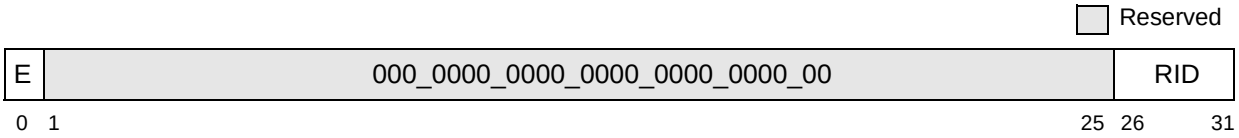


Figure D-21. External Access Register (EAR)

The bit settings for the EAR are described in Table D-15.

Table D-15. External Access Register (EAR) Bit Settings

Bit	Name	Description
0	E	Enable bit 1 Enabled 0 Disabled If this bit is set, the **eciwx** and **ecowx** instructions can perform the specified external operation. If the bit is cleared, an **eciwx** or **ecowx** instruction causes a DSI exception.
1–25	—	Reserved
26–31	RID	Resource ID

D.2 Implementation-Specific Registers from MPC603e

The processor core of the MPC8245 includes some implementation-specific SPRs of the MPC603e processor that are not defined by the PowerPC architecture. Most of these are described in the *MPC603e RISC Microprocessor User's Manual* and are implemented in the MPC8245 as follows:

- MMU software table search registers—DMISS, DCMP, HASH1, HASH2, IMISS, ICMP, and RPA. These registers facilitate the software required to search the page tables in memory and should be accessed only when address translation is disabled (that is, MSR[IR] = 0 and MSR[DR] = 0).
- IABR—This register facilitates the setting of instruction breakpoints.

These registers can be accessed by supervisor-level instructions only. Any attempt to access these SPRs with user-level instructions causes a supervisor-level exception. The SPR numbers for these registers are shown in Figure D-1.

D.2.1 Data and Instruction TLB Miss Address Registers (DMISS and IMISS)

The DMISS and IMISS registers have the same format as shown in Figure D-22. They are loaded automatically upon a data or instruction TLB miss. The DMISS and IMISS contain the effective page address of the access that caused the TLB miss exception. The contents are used by the MPC603e when calculating the values of HASH1 and HASH2, and by the **tlbld** and **tlbli** instructions when loading a new TLB entry. Note that the MPC603e always loads the DMISS register with a big-endian address, even when MSR[LE] is set. These registers can be read and written by software.

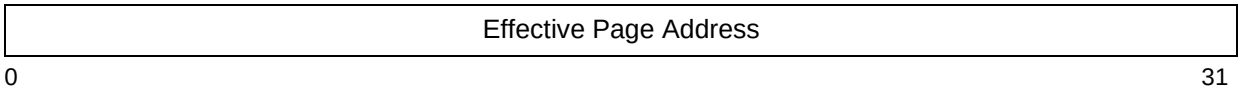


Figure D-22. DMISS and IMISS Registers

D.2.2 Data and Instruction TLB Compare Registers (DCMP and ICMP)

The DCMP and ICMP registers are shown in Figure D-23. These registers contain the first word in the required PTE. The contents are constructed automatically from the contents of the segment registers and the effective address (DMISS or IMISS) when a TLB miss exception occurs. Each PTE read from the tables during the table search process should be compared with this value to determine whether or not the PTE is a match. Upon execution of a **tlbld** or **tlbli** instruction the upper 25 bits of the DCMP or ICMP register and 11 bits of the effective address operand are loaded into the first word of the selected TLB entry. These registers can be read and written by software.

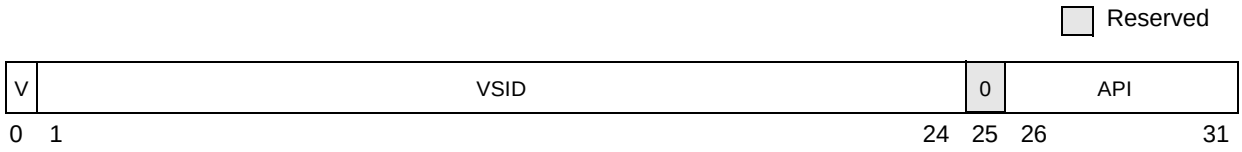


Figure D-23. DCMP and ICMP Registers

Table D-16 describes the bit settings for the DCMP and ICMP registers.

Table D-16. DCMP and ICMP Bit Settings

Bits	Name	Description
0	V	Valid bit. Set by the processor on a TLB miss exception.
1–24	VSID	Virtual segment ID. Copied from VSID field of corresponding segment register.
25	—	Reserved
26–31	API	Abbreviated page index. Copied from API of effective address.

D.2.3 Primary and Secondary Hash Address Registers (HASH1 and HASH2)

The HASH1 and HASH2 registers contain the physical addresses of the primary and secondary PTEGs for the access that caused the TLB miss exception. For convenience, the MPC603e automatically constructs the full physical address by routing bits 0–6 of SDR1 into HASH1 and HASH2 and clearing the lower 6 bits. These registers are read-only and are constructed from the contents of the DMISS or IMISS register (the register choice is determined by which miss was last acknowledged). The format for the HASH1 and HASH2 registers is shown in Figure D-24.

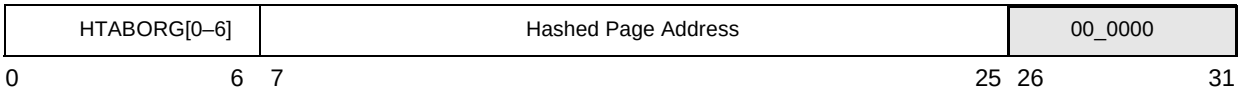


Figure D-24. HASH1 and HASH2 Registers

Table D-17 describes the bit settings of the HASH1 and HASH2 registers.

Table D-17. HASH1 and HASH2 Bit Settings

Bits	Name	Description
0–6	HTABORG[0–6]	Copy of the upper 7 bits of the HTABORG field from SDR1
7–25	Hashed page address	Address bits 7–25 of the PTEG to be searched
26–31	—	Reserved

D.2.4 Required Physical Address Register (RPA)

The RPA register is shown in Figure D-25. During a page table search operation, the software must load the RPA with the second word of the correct PTE. When the **tlbld** or **tlbli** instruction is executed, the contents of the RPA register and the DMISS or IMISS register are merged and loaded into the selected TLB entry. The referenced (R) bit is ignored when the write occurs (no location exists in the TLB entry for this bit). The RPA register can be read and written by software.

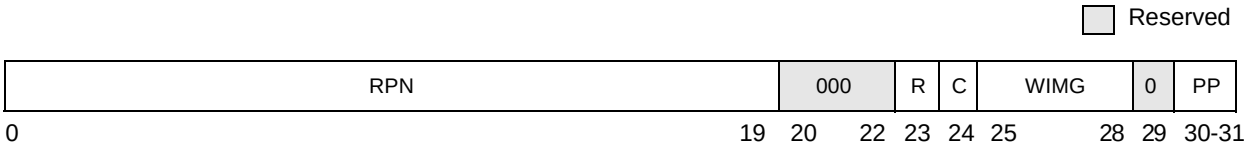


Figure D-25. Required Physical Address Register (RPA)

Table D-18 describes the bit settings of the RPA register.

Table D-18. RPA Bit Settings

Bits	Name	Description
0–19	RPN	Physical page number from PTE
20–22	—	Reserved
23	R	Referenced bit from PTE
24	C	Changed bit from PTE
25–28	WIMG	Memory/cache access attribute bits
29	—	Reserved
30–31	PP	Page protection bits from PTE

D.2.5 Instruction Address Breakpoint Register (IABR)

The IABR, shown in Figure D-26, controls the instruction address breakpoint exception. IABR[CEA] holds an effective address to which each instruction is compared. The exception is enabled by setting bit 30 of IABR. The exception is taken when there is an instruction address breakpoint match on the next instruction to complete. The instruction tagged with the match is not completed before the breakpoint exception is taken.

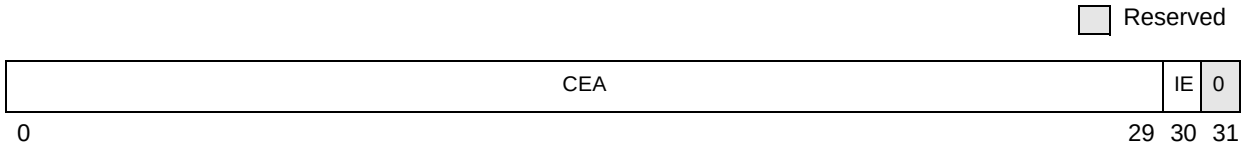


Figure D-26. Instruction Address Breakpoint Register (IABR)

The bits in the IABR are defined as shown in Table D-19.

Table D-19. Instruction Address Breakpoint Register Bit Settings

Bit	Description
0–29	Word address to be compared
30	IABR enabled. Setting this bit indicates that the IABR exception is enabled.
31	Reserved

D.3 MPC8245-Specific Registers

The hardware implementation-dependent registers (HIDx) are implemented differently in the MPC8245 as described in the following subsections.

D.3.1 Hardware Implementation-Dependent Register 0 (HID0)

The processor core's implementation of HID0 differs from the *MPC603e RISC Microprocessor User's Manual* as follows:

- Bit 5, HID0[EICE], has been removed
- No support for pipeline tracking

Figure D-27 shows the MPC8245 implementation of HID0. HID0 can be accessed with **mtspr** and **mfspr** using SPR1008.

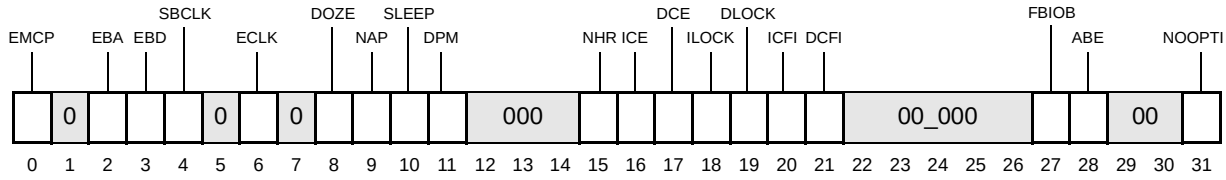


Figure D-27. Hardware Implementation Register 0 (HID0)

Table D-20 shows the bit definitions for HID0.

Table D-20. HID0 Field Descriptions

Bits	Name	Description
0	EMCP	Enable machine check internal signal 0 The assertion of the internal *mcp* signal from the peripheral logic does not cause a machine check exception. 1 Enables the machine check exception based on assertion of the internal $\overline{mcp}$ signal from the peripheral logic to the processor core. Note that the machine check exception is further affected by MSR[ME], which specifies whether the processor checkstops or continues processing.
1	—	Reserved
2	EBA	Enable/disable internal peripheral bus (60x bus) address parity checking 0 Prevents address parity checking 1 Allows a address parity error to cause a checkstop if MSR[ME] = 0 or a machine check exception if MSR[ME] = 1 EBA and EBD let the processor operate with memory subsystems that do not generate parity.
3	EBD	Enable internal peripheral bus (60x bus) data parity checking 0 Parity checking is disabled. 1 Allows a data parity error to cause a checkstop if MSR[ME] = 0 or a machine check exception if MSR[ME] = 1 EBA and EBD let the processor operate with memory subsystems that do not generate parity.
4	SBCLK	CKO output enable and clock type selection. When PMCR1[CKO_SEL] = 0, this bit is used with HID0[ECLK] and the hard reset signals to configure CKO. See Table D-20.
5	—	EICE bit on some other devices that implement the PowerPC architecture. This bit is not used in the MPC8245 (and so it is reserved).

Table D-20. HID0 Field Descriptions (continued)

Bits	Name	Description
6	ECLK	CKO output enable and clock type selection.When PMCR1[CKO_SEL] = 0, this bit is used with HID0[SBCLK] and the hard reset signals to configure CKO. See Table D-20.
7	—	PAR bit used to disable precharge of $\overline{\text{ARTRY}}$ signal on some other devices that implement the PowerPC architecture. This bit is not used in the MPC8245 (and so it is reserved).
8	DOZE	Doze mode enable. Operates with MSR[POW] [1] 0 Processor doze mode disabled. 1 Processor doze mode enabled. Doze mode is invoked by setting MSR[POW] while this bit is set. In doze mode, the PLL, time base, and snooping remain active.
9	NAP	Nap mode enable—Operates with MSR[POW] [1] 0 Processor nap mode disabled 1 Processor nap mode enabled. Nap mode is invoked by setting MSR[POW] while this bit is set. When this occurs, the processor indicates that it is ready to enter nap mode. If the peripheral logic determines that the processor may enter nap mode (no more snooping of the internal buffers is required), the processor enters nap mode after several processor clocks. In nap mode, the PLL and the time base remain active. Note that the MPC8245 asserts the $\overline{\text{QACK}}$ output signal depending on the power-saving state of the peripheral logic, and not on the power-saving state of the processor core.
10	SLEEP	Sleep mode enable—Operates with MSR[POW] [1] 0 Processor sleep mode disabled. 1 Processor sleep mode enabled—Sleep mode is invoked by setting MSR[POW] while this bit is set. When this occurs, the processor indicates that it is ready to enter sleep mode. If the peripheral logic determines that the processor may enter sleep mode (no more snooping of the internal buffers is required), the processor enters sleep mode after several processor clocks. At this point, the system logic may turn off the PLL by first configuring PLL_CFG[0–4] to PLL bypass mode, and then disabling the internal *sys_logic-clk* signal. Note that the MPC8245 asserts the $\overline{\text{QACK}}$ output signal depending on the power-saving state of the peripheral logic, and not on the power-saving state of the processor core.
11	DPM	Dynamic power management enable [1] 0 Processor dynamic power management is disabled. 1 Functional units enter a low-power mode automatically if the unit is idle. This does not affect operational performance and is transparent to software or any external hardware.
12–14	—	Reserved
15	NHR	Not hard reset (software-use only)—Helps software distinguish a hard reset from a soft reset. 0 A hard reset occurred if software had previously set this bit. 1 A hard reset has not occurred. If software sets this bit after a hard reset, when a reset occurs and this bit remains set, software can detect that it was a soft reset.
16	ICE	Instruction cache enable [2] 0 The instruction cache is neither accessed nor updated. All pages are accessed as if they were marked cache-inhibited (WIM = X1X). Potential cache accesses from the bus (snoop and cache operations) are ignored. In the disabled state for the L1 caches, the cache tag state bits are ignored, and all accesses are propagated to the bus as single-beat transactions. For these transactions, however, the processor reflects the original state of the I bit (from the MMU) to the peripheral logic block, regardless of cache disabled status. ICE is zero at power-up. 1 The instruction cache is enabled

Table D-20. HID0 Field Descriptions (continued)

Bits	Name	Description
17	DCE	Data cache enable [2] 0 The data cache is neither accessed nor updated. All pages are accessed as if they were marked cache-inhibited (WIM = X1X). Potential cache accesses from the bus (snoop and cache operations) are ignored. In the disabled state, the cache tag state bits are ignored and all accesses are propagated to the bus as single-beat transactions. For those transactions, however, the processor reflects the original state of the I bit (from the MMU) to the peripheral logic block, regardless of cache disabled status. DCE is zero at power-up. 1 The data cache is enabled.
18	ILOCK	Instruction cache lock 0 Normal operation 1 Instruction cache is locked. A locked cache supplies data normally on a hit, but an access is treated as a cache-inhibited transaction on a miss. On a miss, the transaction to the bus is single-beat. To prevent locking during a cache access, an **isync** must precede the setting of ILOCK.
19	DLOCK	Data cache lock 0 Normal operation 1 Data cache is locked. A locked cache supplies data normally on a hit but an access is treated as a cache-inhibited transaction on a miss. On a miss, the transaction to the bus is single-beat. A snoop hit to a locked L1 data cache performs as if the cache were not locked. A cache block invalidated by a snoop remains invalid until the cache is unlocked. To prevent locking during a cache access, a **sync** must precede the setting of DLOCK.
20	ICFI	Instruction cache flash invalidate [2] 0 The instruction cache is not invalidated. The bit is cleared when the invalidation operation begins (usually the next cycle after the write operation to the register). The instruction cache must be enabled for the invalidation to occur. 1 An invalidate operation is issued to mark the state of each instruction cache block as invalid without writing back modified cache blocks to memory. Cache access is blocked during this time. Accesses to the cache from the peripheral logic bus are signaled as a miss during invalidate-all operations. Setting ICFI clears all the valid bits of the blocks and the PLRU bits to point to way L0 of each set. For MPC603e processors, the proper use of the ICFI and DCFI bits is to set them and clear them with two consecutive **mtspr** operations.
21	DCFI	Data cache flash invalidate [2] 0 The data cache is not invalidated. The bit is cleared when the invalidation operation begins (usually the next cycle after the write operation to the register). The data cache must be enabled for the invalidation to occur. 1 An invalidate operation is issued to mark the state of each data cache block as invalid without writing back modified cache blocks to memory. Cache access is blocked during this time. Accesses to the cache from the peripheral logic bus are signaled as a miss during invalidate-all operations. Setting DCFI clears all the valid bits of the blocks and the PLRU bits so that they point to way L0 of each set. For MPC603e processors, the proper use of the ICFI and DCFI bits is to set them and clear them with two consecutive **mtspr** operations.
22–23	—	Reserved
24	—	IFEM bit on some other devices that implement the PowerPC architecture. This bit is not used in the MPC8245 (and so it is reserved).
25–26	—	Reserved

Table D-20. HID0 Field Descriptions (continued)

Bits	Name	Description
27	FBIOB	Force branch indirect on bus 0 Register indirect branch targets are fetched normally 1 Forces register indirect branch targets to be fetched externally.
28	—	Reserved—Used as address broadcast enable bit on some other devices that implement the PowerPC architecture
29–30	—	Reserved
31	NOOPTI	No-op the data cache touch instructions 0 The **dcbt** and **dcbtst** instructions are enabled. 1 The **dcbt** and **dcbtst** instructions are no-oped globally.

1 See Chapter 9, "Power Management," of the *MPC603e RISC Microprocessor User's Manual* for more information.

2 See Chapter 3, "Instruction and Data Cache Operation," of the *MPC603e RISC Microprocessor User's Manua*l for more information.

Table D-21 shows how HID0[SBCLK], HID0[ECLK], and the hard reset signals are used to configure CKO when PMCR1[CKO_SEL] = 0. When PMCR1[CKO_SEL] = 1, the CKO_MODE field of PMCR1 determines the signal driven on CKO. Note that the initial value of PMCR1[CKO_SEL] is determined by the value on the $\overline{\text{AS}}$ signal at the negation of $\overline{\text{HRST_CPU}}$. See Section 2.2.8.8, "Debug Clock (CKO)—Output," and Section 2.4, "Configuration Signals Sampled at Reset," for more information.

Table D-21. HID0[BCLK] and HID0[ECLK] CKO Signal Configuration

$\overline{\text{HRST_CPU}}$ and HRST_CTRL	HID0[ECLK]	HID0[SBCLK]	Signal Driven on CKO
Asserted	x	x	*sys-logic-clk*
Negated	0	0	High impedance
Negated	0	1	*sys-logic-clk* divided by 2
Negated	1	0	Processor core clock
Negated	1	1	sys-logic-clk

D.3.2 Hardware Implementation-Dependent Register 1 (HID1)

The MPC8245 implementation of HID1 is shown in Figure D-28. HID1 can be accessed with **mfspr** using SPR1009.

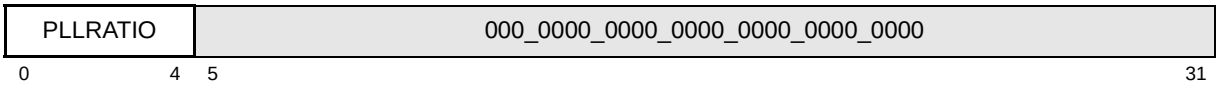


Figure D-28. Hardware Implementation Register 1 (HID1)

Table D-22 shows the bit definitions for HID1.

Table D-22. HID1 Field Descriptions

Bits	Name	Function
0–4	PLLRATIO	PLL configuration processor core frequency ratio—This read-only field is determined by the value on the PLL_CFG[0–4] signals during reset and the processor-to-memory clock frequency ratio defined by that PLL_CFG[0–4] value. See *MPC8245 Integrated Processor Hardware Specifications* for a listing of supported settings. Note that multiple settings of the PLL_CFG[0–4] signals can map to the same PLLRATIO value. Thus, system software cannot read the PLLRATIO value and associate it with a unique PLL_CFG[0–4] value.
5–31	—	Reserved

D.3.3 Hardware Implementation-Dependent Register 2 (HID2)

The processor core implements an additional hardware implementation-dependent register as shown in Figure D-29, not described in the *MPC603e RISC Microprocessor User's Manual*. HID2 can be accessed with **mfspr** using SPR1011.

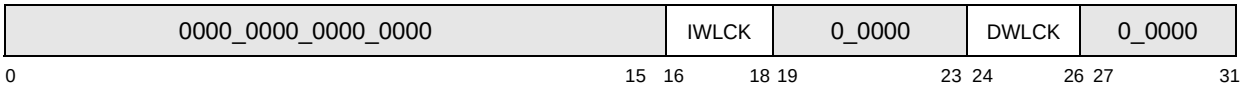


Figure D-29. Hardware Implementation-Dependent Register 2 (HID2)

Table D-23 describes the HID2 fields.

Table D-23. HID2 Field Descriptions

Bits	Name	Function
0–15	—	Reserved
16–18	IWLCK	Instruction cache way lock—Useful for locking blocks of instructions into the instruction cache for time-critical applications where deterministic behavior is required. Refer to Section 5.4.2.3, "Cache Locking," for more information.
19–23	—	Reserved
24–26	DWLCK	Data cache way lock—Useful for locking blocks of data into the data cache for time-critical applications where deterministic behavior is required. Refer to Section 5.4.2.3, "Cache Locking," for more information.
27–31	—	Reserved

Appendix E
Revision History

This appendix provides a list of the major differences between the *MPC8245 Integrated Processor User's Manual*, Rev. 1 and the *MPC8245 Integrated Processor User's Manual*, Rev. 2.

E.1 Revision Changes From Revision 1 to Revision 2

Major changes to the *MPC8245 Integrated Processor User's Manual* from Revision 1 to Revision 2 are as follows:

Section, Page	Changes
Throughout the user's manual	The acronym EPIC should be changed to PIC. The following register names should be changed: EICR should be ICR and EVI should be IVI.
1.1.1, 1-4	The second bullet under the '32-bit PCI Interface' heading should read: PCI 2.2-compatible
2.1, 2-3	In Figure 2-1, "MPC8245 Signal Groupings," the CST1 signal listed in the DUART/PCI clock group should be $\overline{\text{CTS1}}$. Also, the RTC signal listed in the clock group should be removed. RTC is a test input, *reserved for factory use only.*
2.1.1, 2-4	In Table 2-1, "MPC8245 Signal Cross Reference," the following signals should have an overbar: $\overline{\text{CHKSTOP_IN}}$, $\overline{\text{CTS1}}$, $\overline{\text{DEVSEL}}$, $\overline{\text{DRDY}}$, $\overline{\text{FRAME}}$, $\overline{\text{GNT}}$[4:0], $\overline{\text{HRST_CPU}}$, $\overline{\text{HRST_CTRL}}$, $\overline{\text{INTA}}$, $\overline{\text{IRDY}}$, $\overline{\text{L_INT}}$, $\overline{\text{LOCK}}$, $\overline{\text{MIV}}$, $\overline{\text{PERR}}$, $\overline{\text{RCS}}$[3:0], $\overline{\text{REQ}}$[4:0], $\overline{\text{RTS1}}$, $\overline{\text{SDCAS}}$, $\overline{\text{SDRAS}}$, $\overline{\text{SERR}}$, $\overline{\text{S_FRAME}}$, $\overline{\text{SMI}}$, $\overline{\text{SRESET}}$, $\overline{\text{STOP}}$, $\overline{\text{TRDY}}$, $\overline{\text{TRST}}$, and $\overline{\text{WE}}$. Also in Table 2-1, the RTC signal should be removed. Replace the row describing SDMA[11:0] with the following:

SDMA[1:0] [1]	SDRAM address 1–0	Memory	See Table 6-2	2	O	2.2.2.4
SDMA[11:2]	SDRAM address 11–2	Memory		10	O	2.2.2.4

2.1.1, 2-4 — In Table 2-1, "MPC8245 Signal Cross Reference," replace $\overline{\text{GNT}}$[3:0] and $\overline{\text{REQ}}$[3:0] signals with $\overline{\text{GNT}}$[4:0] and $\overline{\text{REQ}}$[4:0], respectively.

2.1.1, 2-7 — In Table 2-2, "Output Signal States During System Reset," the following signals should have an overbar:

$\overline{\text{INTA}}$, $\overline{\text{RCS1}}$, $\overline{\text{SDRAS}}$, $\overline{\text{SDCAS}}$, and $\overline{\text{WE}}$

2.2.2.3, 2-18 — Add the following to the timing comments in Section 2.2.2.3, "Write Enable ($\overline{\text{WE}}$)—Output:"

Assertion: For writes to base or extended ROM space, the MPC8245 asserts $\overline{\text{WE}}$ one clock cycle after $\overline{\text{RCS}}$*n* is asserted.

Negation: For writes to base or extended ROM space, the MPC8245 negates $\overline{\text{WE}}$ one clock after $\overline{\text{RCS}}$*n* is negated.

2.2.2.3, 2-18 — Add the following to the end of the Timing Comments for $\overline{\text{WE}}$:

For Flash, the MPC8245 asserts $\overline{\text{WE}}$ one clock cycle after $\overline{\text{RCS}}$*n* is asserted and negates $\overline{\text{WE}}$ one clock cycle after $\overline{\text{RCS}}$*n* is negated.

2.2.6.10, 2-32 — Section 2.2.6.10, "Performance Monitor Real Time Clock (RTC)—Input," and all other references to the RTC signal should be removed. RTC is a test input, *reserved for factory use only.*

2.4, 2-43 — In Table 2-5, "MPC8245 Reset Configuration Signals," the following signals should have an overbar:

$\overline{\text{AS}}$, $\overline{\text{QACK}}$, $\overline{\text{RCS0}}$, and $\overline{\text{GNT4}}$

2.4, 2-44 — In Table 2-5, "MPC8245 Reset Configuration Signals," the PMAA2 signal should have a default value of 1. Note that negating the signal results in a 20-Ω drive capability on listed signals and asserting the signal results in a 40-Ω drive capability on listed signals. Replace the PMAA2 row as follows:

PMAA2	1	Driver capability for the PCI and PIC controller output signals. The value of this signal sets the initial value of ODCR[DRV_PCI]. 0 20-Ω drive capability on AD[31:0], $\overline{\text{C/BE}}$[3:0], $\overline{\text{DEVSEL}}$, $\overline{\text{FRAME}}$, $\overline{\text{GNT}}$[4:0], PAR, $\overline{\text{INTA}}$, $\overline{\text{IRDY}}$, $\overline{\text{PERR}}$, $\overline{\text{SERR}}$, $\overline{\text{STOP}}$, $\overline{\text{TRDY}}$, IRQ0/S_INT, IRQ1/S_CLK, and IRQ4/L_$\overline{\text{INT}}$ signals and a 6-Ω drive capability on IRQ2/S_RST and IRQ3/S_$\overline{\text{FRAME}}$ 1 40-Ω drive capability on PCI/PIC signals

2.4, 2-44 — In Table 2-5, "MPC8245 Reset Configuration Signals," the default state of the signal $\overline{\text{QACK}}$ should be "0" instead of "1."

2.4, 2-44 — In Table 2-5, "MPC8245 Reset Configuration Signals," the default state of the signals MDH[16:31] and MDH[0:15] should be marked "x" instead of "must be driven," and two notes should be added to read as follows:

MDH[16:31]	x [1]	Sets the initial value of the PCI Subsystem Vendor ID register (at offset 0x2C).
MDH[0:15]	x [2]	Sets the initial value of the PCI Subsystem ID register (at offset 0x2E).

[1] The MDH[16:31] signal should be driven at reset to determine the initial value of the PCI Subsystem Vendor ID, but alternatively 0x2C can be programmed during initialization.

[2] The MDH[0:15] signal should be driven at reset to determine the initial value of the PCI Subsystem ID, but alternatively 0x2E can be programmed during initialization.

3.1, 3-4 In Table 3-14, delete footnote 13. This information is covered in Section 3.3.2.

3.1, 3-5 In Figure 3-2, replace ‘PCI memory address in 2GB to 2GB–32MB range’ in PCI Master Memory Space with ‘PCI memory address in 2GB to 4GB–16MB range.’ Replace Figure 3-2 with the following:

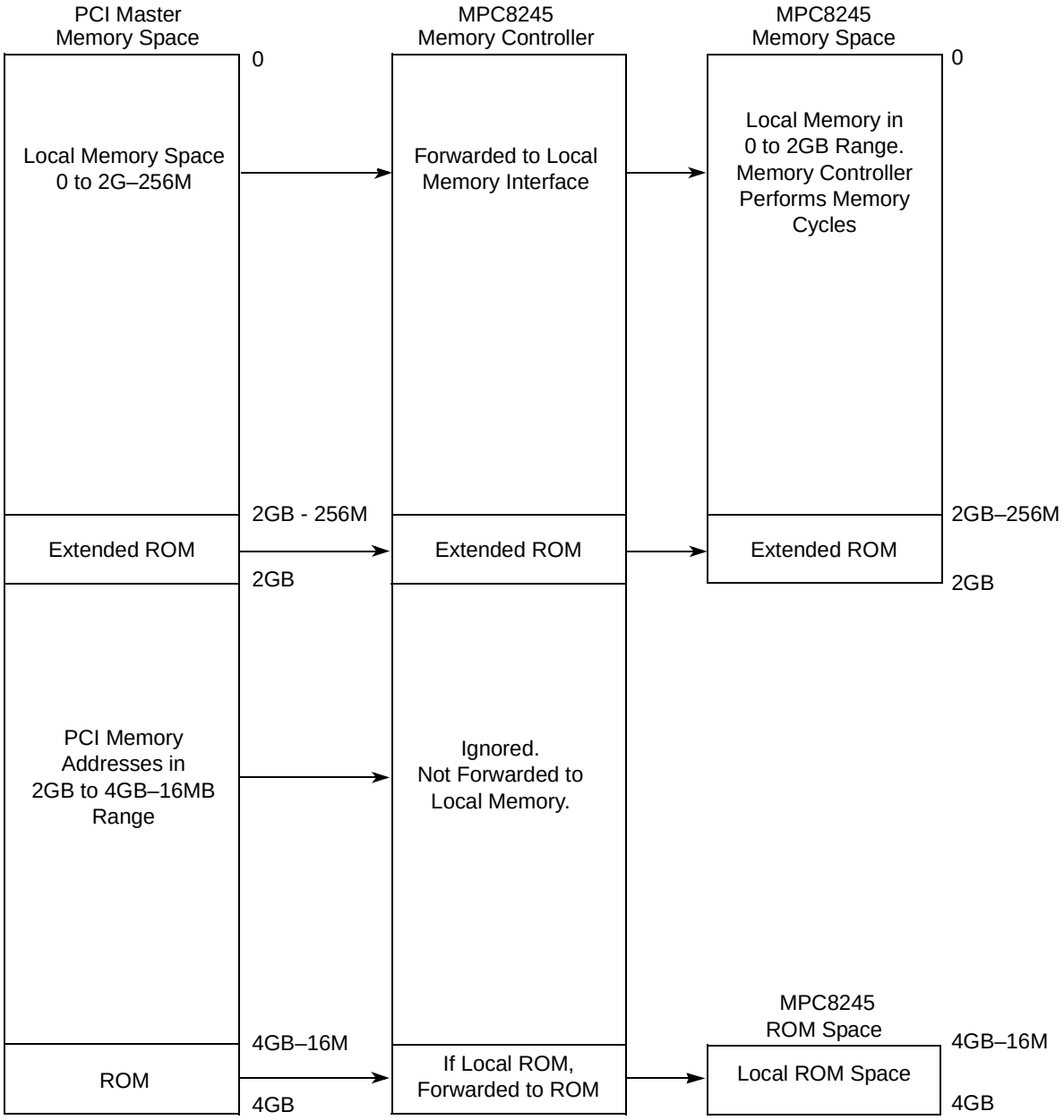


Figure 3-2. PCI Memory Master Address Map B in Host Mode

3.3.1, 3-11 Move the last sentence “The translated address should...between 2G to 4G.” (bottom of the page) to the end of the first paragraph.

3.3.1, 3-11 In Figure 3-6, delete ‘1G’ and the line from the Processor Core View, and 1G to 2G is not reserved. Replace Figure 3-6 with the following:

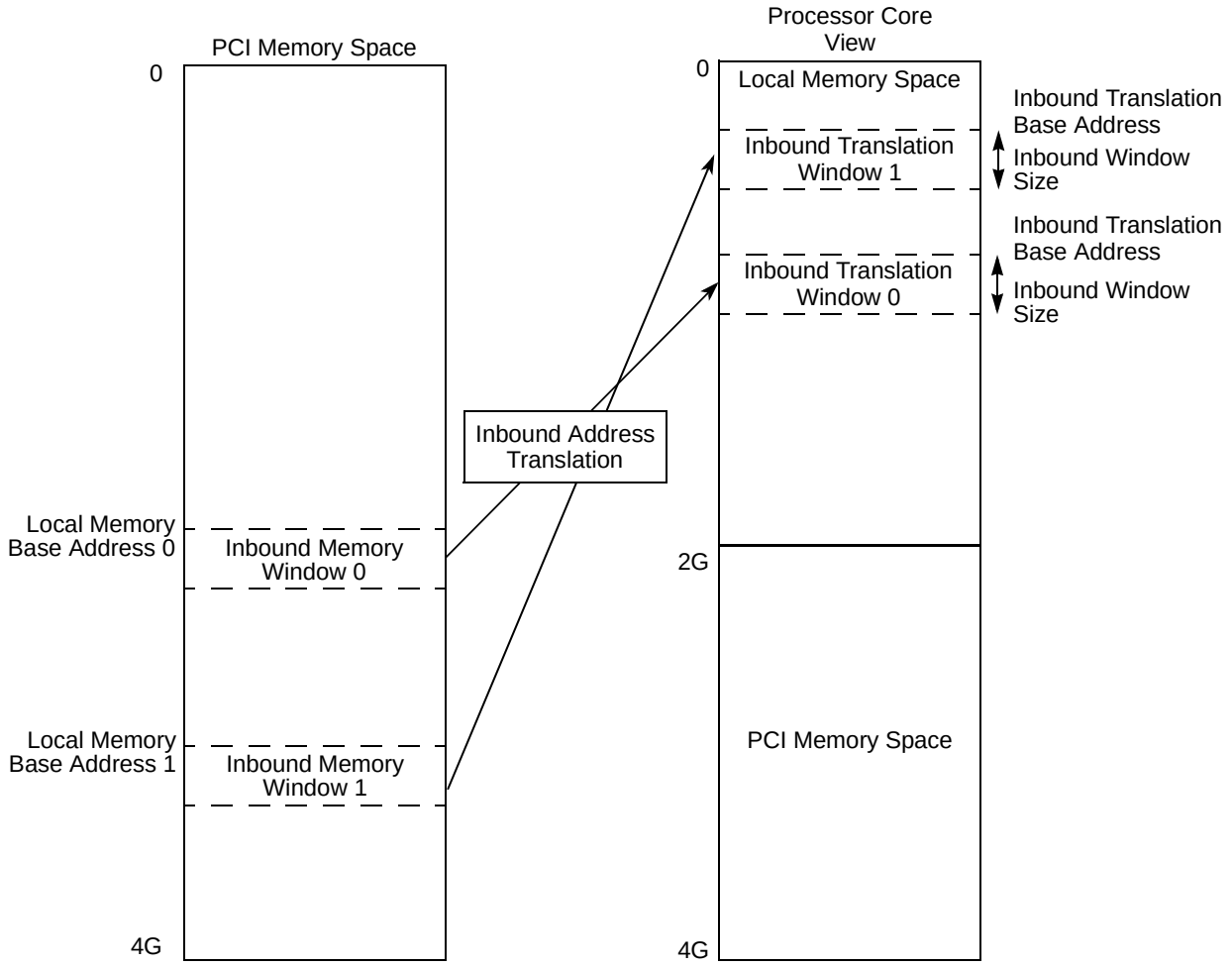


Figure 3-6. Inbound PCI Address Translation

3.4, 3-23 In Section 3.4, “Embedded Utilities Memory Block (EUMB),” the third sentence of the second paragraph should read as follows:

In the processor’s local memory map, the registers that comprise the EUMB (specified by the EUMBBAR) are restricted to locations 0x8000_0000 to 0xFDFF_FFFF; see Section 3.1, “Address Map B.”

4.1.3.1, 4-5 In Table 4-1, “MPC8245 Configuration Registers Accessible from the Processor Core,” at offset 0xB8, the ECC single bit error counter should be Read/Bit Reset access.

4.2, 4-10 In Table 4-3, “PCI Configuration Space Header Summary,” in the address offset 0x09 row, delete '(0x00)' from the description. The description should read as follows:

0x09	Standard programming interface	Identifies the register-level programming interface of the MPC8245

In the address offset 0x0A row, delete '(0x00 = host bridge)' from the description. The description should read as follows:

0x0A	Subclass code	Identifies more specifically the function of the MPC8245

In the address offset 0x0B row, replace the description with the following:

0x0B	Base class code	Broadly classifies the type of function the MPC8245 performs (Host mode = 0x06 bridge device, Agent mode = 0x0E intelligent I/O controller)

4.2, 4-10 The following paragraph does not apply to the MPC8245 and should be removed:

Note that the MPC8245 must not issue PCI configuration transactions to itself (that is, for PCI configuration transactions initiated by the MPC8245, its IDSEL input signal must not be asserted).

4.2.11, 4-16 In Table 4-15, “PCI General Control Register Bit Definitions—0x44,” in the description for bits 2–1, setting 10, replace; ‘Disconnect issued after 33 PCI clocks,’ with ‘Disconnect issued after 32 PCI clocks.’ Replace the bits 2–1 row with the following:

2–1	00	R/W	Subsequent latency timer disconnect count. The MPC8245 issues a disconnect if the MPC8245, as a target, cannot provide data from PCI masters with in the clock interval indicated below. The MPC8245 is a PCI 2.2 compatible device. 00 Disconnect issued after 8 PCI clocks 01 Disconnect issued after 16 PCI clocks 10 Disconnect issued after 32 PCI clocks 11 Disconnect issued after 64 PCI clocks

4.3.2, 4-20 In Table 4-18, “Power Management Configuration Register 2—0x72,” the description of PCI_HOLD_DEL (bits 5–4) should state that there are four sequential settings for the PCI output hold delay value. Replace the bits 5–4 row as follows:

5–4	PCI_HOLD_DEL	xx [1]	PCI output hold delay value relative to the PCI_SYNC_IN signal. See the *MPC8245 Integrated Processor Hardware Specifications* for the detailed number of nanoseconds guaranteed for each setting. There are four sequential settings for this value, each corresponds to a set increase in hold time: 00 Recommended for 66 MHz PCI bus (default) 01 10 Recommended for 33 MHz PCI bus 11 The initial values of bits 5 and 4 are determined by the inverse of $\overline{\text{MCP}}$ and CKE reset configuration signals, respectively. See Section 2.4, “Configuration Signals Sampled at Reset,” for more information. As these two pins have internal pull-up resistors, the default value after reset is 0b00.

4.4, 4-21

In Table 4-19, “Output Driver Control Register Bit Definitions—0x73,” bit 7 should have an impedance of 20 Ω when cleared and an impedance of 40 Ω when set.

Bit 6 should be reserved.

Also, the description of bits 5–4, signal TRIG_OUT should be modified as “$\overline{\text{RCS3}}$/TRIG_OUT”

The description of bits 5–4 should be modified. These changes are as follows:

msb 7	DRV_PCI	x [1]	Driver capability for the PCI and PIC controller output signals. 0 20-Ω drive capability on AD[31:0], C/BE[3:0], DEVSEL, FRAME, GNT[4:0], PAR, INTA, IRDY, PERR, SERR, STOP, TRDY, IRQ0/S_INT, IRQ1/S_CLK, and IRQ4/L_IN signals and 6-Ω drive capability on IRQ2/S_RST and IRQ3/S_FRAME. 1 40-Ω drive capability on PCI/PIC signals The initial value of this bit is determined by the PMAA2 reset configuration pin.
6	—	1	Reserved [2]
5–4	DRV_MEM_CTRL[1–2]	xx [1]	Driver capability for the standard and memory signals ($\overline{\text{CS}}$[0:7], DQM[0:7], $\overline{\text{WE}}$, $\overline{\text{FOE}}$, $\overline{\text{RCS0}}$, $\overline{\text{RCS1}}$, SDBA[1:0], $\overline{\text{SDRAS}}$, $\overline{\text{SDCAS}}$, CKE, $\overline{\text{AS}}$, SDMA[11:0], $\overline{\text{CHKSTOP_IN}}$, $\overline{\text{SRESET}}$, TBEN, TRIG_OUT, PMAA[0:2], SDA, SCL, CKO, $\overline{\text{QACK}}$, DA[10:6], $\overline{\text{MCP}}$, MDH[0:31], MDL[0:31], PAR[0:7], and MAA[0:2]). Controls drive strength of SDRAM_CLK[0:3] and SDRAM_SYNC_OUT for silicon revisions 1.0 and 1.1. DRV_MEM_CTRL[1–2]: 00 Reserved 01 40-Ω drive capability for all standard and memory signals (including the SDRAM_SYNC_OUT and SDRAM clocks of part revisions 1.0 and 1.1). 10 20-Ω drive capability for all standard and memory signals (including the SDRAM_SYNC_OUT and SDRAM clocks of part revisions 1.0 and 1.1). 11 20-Ω drive capability for the following standard and memory signals: PMAA[0:2], SDA, SCL, CKO, $\overline{\text{QACK}}$, DA[10:6], $\overline{\text{MCP}}$, MDH[0:31], MDL[0:31], PAR[0:7], and MAA[0:2]; 6-Ω drive capability for all other memory signals (including the SDRAM_SYNC_OUT and SDRAM clocks of part revisions 1.0 and 1.1). The initial value of DRV_MEM_CTRL[1–2] is determined by the PMAA0 and PMAA1 reset configuration pins, respectively.

[1] See initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”
[2] Refer to Chip Errata No. 19 in the *MPC8245 Integrated Processor Chip Errata*.

4.4, 4-22

In Table 4-20, “CLK Driver Control Register Bit Definitions—0x74,” the reset value of the bit 7 is “0” instead of “x”. Delete the note, since it does not apply to this bit. The bit should read as follows:

7	—	0	Reserved

4.4, 4-23 In Table 4-21, “Miscellaneous I/O Control Register 1 Bit Definitions—0x76,” bit 1 should not be a reserved bit. The description of the bit 1 should read as follows:

1	CLK_FLIP	x [1]	Read only. This bit indicates the inverse of the clock-flip disable ($\overline{\text{QACK}}$) configuration signal during reset. See 2.3.3, “Clock Synchronization,” for more information about the use of clock flipping. 0 Clock flipping is disabled, $\overline{\text{QACK}}$ is pulled high at reset 1 Clock flipping is enabled, $\overline{\text{QACK}}$ is pulled low at reset

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.4, 4-23 In Table 4-21, “Miscellaneous I/O Control Register 1 Bit Definitions—0x76,” bit 6 should be a reserved bit.

4.4, 4-23 In Table 4-22, “Miscellaneous I/O Control Register 2 Bit Definitions—0x77,” bits 5–4, SDRAM_DSCD, should have a reset value of 10.

5–4	SDRAM_DSCD	10	SDRAM data in sample clock delay. These bits are used to select the desired minimum SDRAM_SYNC_IN input setup and hold times. The setup time increases as the field value decreases and hold time decreases as the field decreases. See the *MPC8245 Integrated Processor Hardware Specifications* for more information about the setting of these bits.

4.7, 4-30 In Figure 4-17, “Processor Interface Configuration Register 1 (PICR1)—0xA8,” bits 31–24 should have a default value of all 0s. Replace Figure 4-17 with the following:

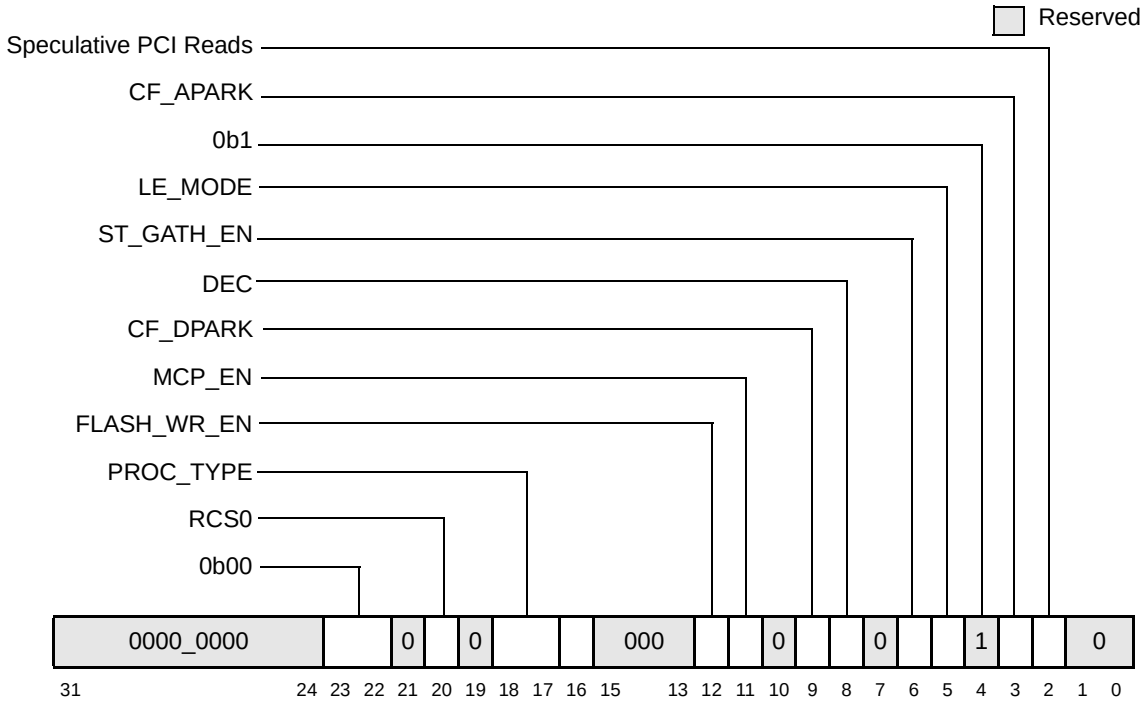


Figure 4-17. Processor Interface Configuration Register 1 (PICR1)—0xA8

4.7, 4-31 In Table 4-30, “Bit Settings for PICR1—0xA8,” bit 7, NO_BUS_WIDTH_CHECK, the description should be replaced with the following:

7	NO_BUS_ WIDTH_CHECK	0	This bit controls whether the MPC8245 checks the data path size of processor writes to local base ROM space. See Section 14.3.1.2, “Flash Write Error,” for more information. 0 Bus width check is enabled. An attempt to write to Flash with a transfer size other than the base ROM data bus size (for example, a 32-bit write to an 8-bit Flash) may cause a Flash write error. 1 Bus width check is disabled. An attempt to write to Flash with a transfer size other than the base ROM data bus size does not cause a Flash write error.

4.7, 4-32 In Figure 4-18, “Processor Interface Configuration Register 2 (PICR2)—0xAC,” bits 9 and 10 should be reserved. Replace Figure 4-18 with the following:

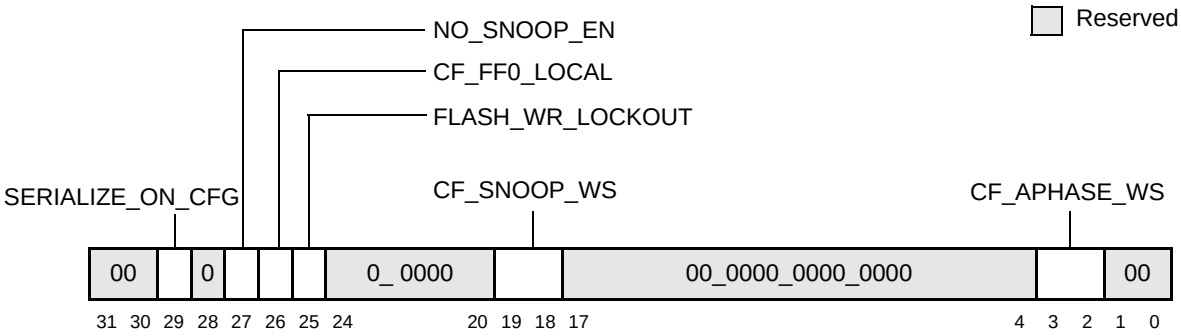


Figure 4-18. Processor Interface Configuration Register 2 (PICR2)—0xAC

4.8.2, 4-34 Replace the first sentence of the first paragraph with the following:

The error enabling registers 1 and 2 (ErrEnR1 and ErrEnR2), shown in Figure 4-21 and Figure 4-24, control whether the MPC8245 recognizes and reports specific error conditions.

4.8.2, 4-35 Replace the first sentence of the first paragraph of this page (second paragraph of this section) with the following:

The error detection registers 1 and 2 (ErrDR1 and ErrDR2), shown in Figure 4-22 and Figure 4-25, contain error flags that report when the MPC8245 detects a specific error condition.

Replace the fourth paragraph of this page (fifth paragraph of this section) with the following:

The PCI bus error status register and processor/PCI error address register are described in Figure 4-26 and Figure 4-27.

4.8.2, 4-36 In Table 4-34, “Bit Settings for Error Enabling Register 1 (ErrEnR1)—0xC0,” the first sentence of the description of Memory parity/ECC enable, bit 2, should state:

This bit enables the reporting of system memory read parity errors that occur on accesses to system memory or those that equal the ECC single-bit error threshold.

4.8.2, 4-38 In Table 4-37, “Bit Settings for Error Enabling Register 2 (ErrEnR2)—0xC4,” and Table 4-38, “Bit Settings for Error Detection Register 2 (ErrDR2)—0xC5,” bit 6 should be reserved.

4.8.2, 4-38 Replace Figure 4-24 with the following, as bit 6 “PCI SERR enable” of the Error Enabling Register 2 should be reserved:

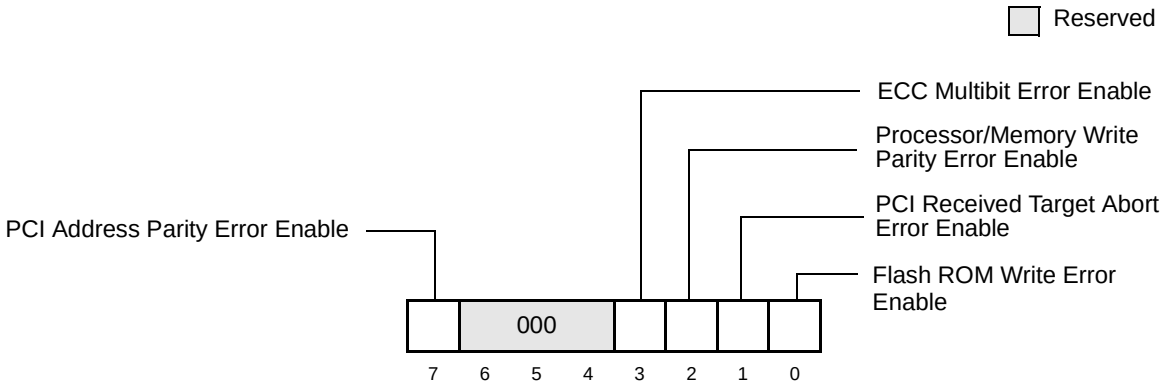


Figure 4-24. Error Enabling Register 2 (ErrEnR2)—0xC4

4.8.2, 4-39 Replace Figure 4-25 with the following, as bit 6 “PCI SERR error” of the Error Detection Register 2 should be reserved:

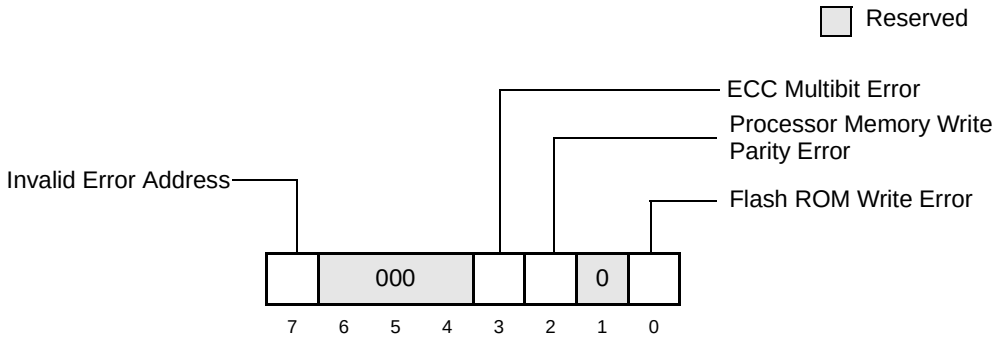


Figure 4-24. Error Detection Register 2 (ErrDR2)—0xC5

4.9, 4-42 In Table 4-41, “Extended ROM Configuration Register 1—0xD0,” the last sentence, ‘Note that this timing is only... if ERCR1[RCS2_CTL] = 01,’ of the bit descriptions for RCS2_ROMFAL (bits 24–20) should state:

Note that this timing is only in effect if ERCR1[RCS2_CTL] ≠ 01.

The last sentence, ‘Note that this timing is only... if ERCR1[RCS2_CTL] = 01,’ of the bit descriptions for RCS2_ROMNAL (bits 19–15) should state:

Note that this timing is only in effect if ERCR1[RCS2_CTL] = 00.

Also in Table 4-41, the bit description for RCS2_ROMNAL (bits 19–15) should state that the maximum value for RCS2_ROMNAL is 0b11111 (31).

Replace RCS2_ROMFAL (bits 24–20) and RCS2_ROMNAL (bits 19–15) rows with the following:

24–20	RCS2_ROMFAL	All 1s	For nonburst ROM and Flash reads, RCS2_ROMFAL controls the access time. For burst-mode ROMs, RCS2_ROMFAL controls the first access time. The maximum value is 0b11111 (31). For 64- and 32-bit configurations, the actual cycle count is three cycles more than the binary value of RCS2_ROMFAL. For the 8-bit configuration, the actual cycle count is two cycles more than the binary value of RCS2_ROMFAL. For Flash writes, RCS2_ROMFAL measures the write pulse low time. The maximum value is 0b11111 (31). The actual cycle count is two cycles more than the binary value of RCS2_ROMFAL. Note that this timing is only in effect if ERCR1[RCS2_CTL] ≠ 01.
19–15	RCS2_ROMNAL	All 1s	For burst-mode ROM and Flash reads, RCS2_ROMNAL controls the next access time. The maximum value is 0b11111 (31). The actual cycle count is three cycles more than the binary value of RCS2_ROMNAL. For Flash writes, RCS2_ROMNAL measures the write pulse recovery (high) time. The maximum value is 0b11111 (31) The actual cycle count is four cycles more than the binary value of RCS2_ROMNAL. Note that this timing is only in effect if ERCR1[RCS2_CTL] = 00.

4.9, 4-43 In Table 4-41, “Extended ROM Configuration Register 1-0xD0,” in the bits description of 4–0, delete the sentence, ‘Note that this parameter... SDRAM systems only.’ This note is deleted as the MPC8245 only supports SDRAM.

4.9, 4-44 In Table 4-42, “Extended ROM Configuration Register 2—0xD4,” the first sentence of the bit descriptions of msb 31 should read, ‘ROM chip-select 3 enable’ instead of ‘ROM chip-select 2 enable.’ Replace the msb 31 row with the following:

msb 31	RCS3_EN	1	ROM chip-select 3 enable 0 RCS3 disabled 1 RCS3 enabled

4.9, 4-44 In Table 4-42, “Extended ROM Configuration Register 2—0xD4,” the last sentence, ‘Note that this timing is only... if ERCR2[RCS3_CTL] = 01,’ of the bit descriptions for RCS3_ROMFAL (bits 24–20) should state:

Note that this timing is only in effect if ERCR2[RCS3_CTL] ≠ 01

The last sentence, ‘Note that this timing is only... if ERCR2[RCS3_CTL] = 01,’ of the bit descriptions for RCS3_ROMNAL (bits 19–15) should state:

Note that this timing is only in effect if ERCR2[RCS3_CTL] = 00.

Also in Table 4-42, the bit description for RCS3_ROMNAL (bits 19–15) should state that the maximum value for RCS3_ROMNAL is 0b11111 (31).

Replace RCS3_ROMFAL (bits 24–20) and RCS3_ROMNAL (bits 19–15) rows with the following:

24–20	RCS3_ROMFAL	All 1s	For nonburst ROM and Flash reads, RCS3_ROMFAL controls the access time. For burst-mode ROMs, RCS3_ROMFAL controls the first access time. The maximum value is 0b11111 (31). For 64- and 32-bit configurations, the actual cycle count is three cycles more than the binary value of RCS3_ROMFAL. For the 8-bit configuration, the actual cycle count is two cycles more than the binary value of RCS3_ROMFAL. For Flash writes, RCS3_ROMFAL measures the write pulse low time. The maximum value is 0b11111 (31). The actual cycle count is two cycles more than the binary value of RCS3_ROMFAL. Note that this timing is only in effect if ERCR2[RCS3_CTL] ≠ 01.
19–15	RCS3_ROMNAL	All 1s	For burst-mode ROM and Flash reads, RCS3_ROMNAL controls the next access time. The maximum value is 0b11111 (31). The actual cycle count is three cycles more than the binary value of RCS3_ROMNAL. For Flash writes, RCS3_ROMNAL measures the write pulse recovery (high) time. The maximum value is 0b11111 (31). The actual cycle count is four cycles more than the binary value of RCS3_ROMNAL. Note that this timing is only in effect if ERCR2[RCS3_CTL] = 00.

4.9, 4-46 In Table 4-42, “Extended ROM Configuration Register 2—0xD4,” in the bits description of 4–0, delete the sentence, ‘Note that this parameter... SDRAM systems only.’ This note is deleted because the MPC8245 supports only SDRAM.

4.9, 4-47 Table 4-43, “Extended ROM Configuration Register 3—0xD8,” should contain all of the following settings in the description of bits 3–0, RCS2_SIZE:

3–0	RCS2_SIZE	0b1110	Encoded sizes of RCS2: 0000 = 4 Kbytes 0100 = 64 Kbytes 1000 = 1 Mbyte 1100 = 16 Mbytes 0001 = 8 Kbytes 0101 = 128 Kbytes 1001 = 2 Mbytes 1101 = 32 Mbytes 0010 = 16 Kbytes 0110 = 256 Kbytes 1010 = 4 Mbytes 1110 = 64 Mbytes 0011 = 32 Kbytes 0111 = 512 Kbytes 1011 = 8 Mbytes 1111 = 128 Mbytes 1110 is the default setting for RCS2_SIZE

4.9, 4-47 Table 4-44, “Extended ROM Configuration Register 4—0xDC,” should contain all of the following settings in the description of bits 3–0, RCS3_SIZE:

3–0	RCS3_SIZE	0b1110	Encoded sizes of RCS3:. 0000 = 4 Kbytes 0100 = 64 Kbytes 1000 = 1 Mbytes 1100 = 16 Mbytes 0001 = 8 Kbytes 0101 = 128 Kbytes 1001 = 2 Mbytes 1101 = 32 Mbytes 0010 = 16 Kbytes 0110 = 256 Kbytes 1010 = 4 Mbytes 1110 = 64 Mbytes 0011 = 32 Kbytes 0111 = 512 Kbytes 1011 = 8 Mbytes 1111 = 128 Mbytes 1110 is the default setting for RCS3_SIZE

4.10, 4-48

In Table 4-45, “Bit Settings for the AMBOR—0xE0,” add the following two sentences after the last sentence of the first paragraph of the description of bit 5, “DLL_RESET”:

This resetting should be done after programming register 0x72 and 0x76 according to the desired DLL locking mode. See the hardware specification document for more details about the DLL locking modes and their related graphs.

The bit description should read as follows:

5	DLL_RESET	0	Resets the DLL tap point. See Section 2.3.2, “DLL Operation and Locking.” This bit must be explicitly set and then cleared by software during initialization to guarantee correct operation of the DLL and the SDRAM_CLK[0:3] signals (if they are used). See the hardware specification document for more details about the DLL locking modes and their related graphs. 0 DLL tries to lock the phase between the SDRAM_SYNC_IN signal and the internal *sys_logic_clk* signal. 1 The SDRAM_CLK signals are driven from tap point 0 of the internal delay line.

4.10, 4-49

Add the following paragraph, Figure 4-31, and Table 4-46 under a new section 4.11 called “PCI/Memory Buffer Configuration Register—0xE1,” after Section 4.10, “Address Map B Options Register—0xE0.

The PCI/Memory buffer configuration register (PCMBCR) controls various configuration settings. Figure 4-31 shows the PCMBCR bits.

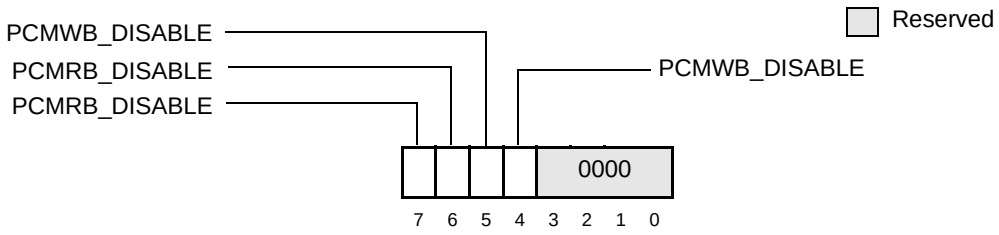


Figure 4-31.PCI/Memory Buffer Configuration Register (PCMBCR)—0xE1

Table 4-46 shows the specific bit settings for this register.

Table 4-46 Bit Settings for this register—0xE1

Bits	Name	Reset Value	Description
7–6	PCMRB_DISABLE	00	These bits control the number of PCMRBs that the MPC8245 uses. This parameter is primarily used for system debugging. To ensure maximum performance, all PCMRBs should be enabled. 00 All (4) PCMRBs enabled. 01 1 PCMRB disabled; 3 PCMRBs available 10 2 PCMRBs disabled; 2 PCMRBs available 11 3 PCMRBs disabled; 1 PCMRB available
5–4	PCMWB_DISABLE	00	These bits control the number of PCMWBs that the MPC8245 enables. This parameter is primarily used for system debugging. To ensure maximum performance, all PCMWBs should be enabled. 00 All (4) PCMWBs enabled 01 1 PCMWB disabled; 3 PCMWBs available 10 2 PCMWBs disabled; 2 PCMWBs available 11 3 PCMWBs disabled; 1 PCMWB available
3	—	0	Reserved
2	—	0	Reserved
1	—	0	Reserved
0	—	0	Reserved

4.11, 4-49 Add Table 4-47, “Bit Settings for this Register—0xE3,” under a new section 4.12 called “Register—0xE3,”after section 4.11 “PLL Configuration Register—0xE2.” The table shows the specific bit settings for this register.

Bits	Name	Reset Value	Description
7	HOST_MODE	x [1]	Determines mode of MPC8245.This bit is read-only. 1 MPC8245 is in host mode. 0 MPC8245 is in agent mode.
6–0	DLL_TAP_COUNT	xx	DLL_TAP_COUNT provides the value of the current DLL tap point. This value can determine if the DLL has stabilized or if the DLL is advancing or decrementing.

[1] Initial value depends on reset configuration signal. See Section 2.4, “Configuration Signals Sampled at Reset.”

4.12, 4-52 In Figure 4-33, “Memory Control Configuration Register 2 (MCCR2)—0xF4,” bit 17 should be reserved.

4.12, 4-52 In Figure 4-33, “Memory Control Configuration Register 2 (MCCR2)—0xF4,” bit 19 should be called “INLINE_WR_EN”

instead of “WRITE_PARITY_CHK.” Replace Figure 4-33 with the following:

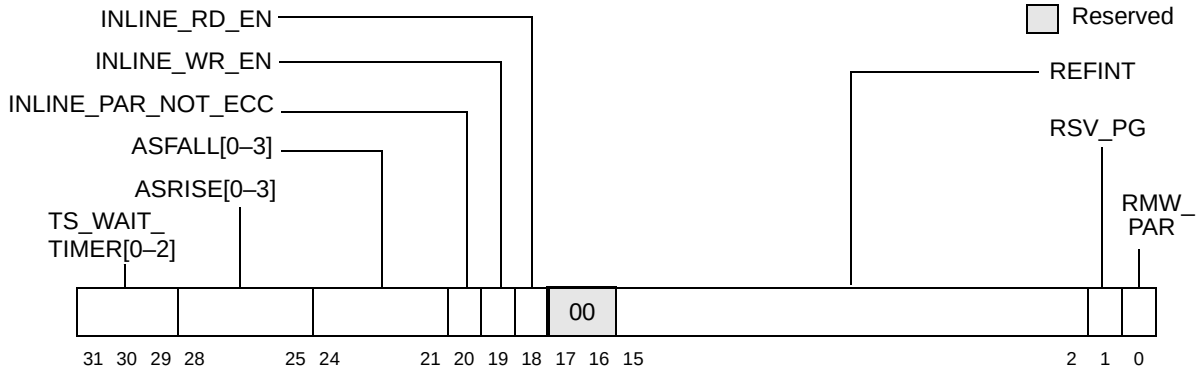


Figure 4-33. Memory Control Configuration Register 2 (MCCR2)—0xF4

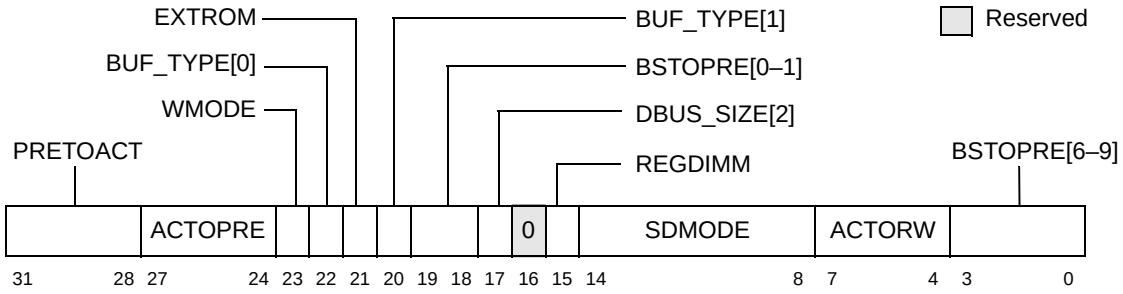
4.12, 4-53 In Table 4-48, “Bit Settings for MCCR2—0xF4,” delete the sentence, ‘Note that this parameter... SDRAM systems only.’ from the bits description of 31–29.

4.12, 4-54 In Table 4-48, “Bit Settings for MCCR2—0xF4,” the description for INLINE_RD_EN (bit 18) and RMW_PAR (bit 0) should not contain reference to MCCR2[ECC_EN]. Replace INLINE_RD_EN (bit 18) and RMW_PAR (bit 0) rows as follows:

18	INLINE_RD_ EN	0	In-line read parity or ECC check/correction enable. This bit controls whether the MPC8245 uses the ECC/parity checking and/or correction hardware in the in-line data path to report ECC or parity errors on memory system read operations. This bit activates different parity/ECC checking/correction hardware than that controlled by PCKEN. Read parity/ECC checking can be enabled for SDRAM systems running in in-line buffer mode (MCCR4[BUF_TYPE[0–1]] = 0b10) only. Also, note that the INLINE_PAR_NOT_ECC bit selects between parity or ECC on the memory data bus when this bit is set. 0 In-line memory bus read parity/ECC error reporting disabled 1 In-line memory bus read parity/ECC error reporting enabled. Note that MCCR1[PCKEN] must be cleared when this bit is set.

0	RMW_PAR	0	Read-modify-write (RMW) parity enable. This bit controls how the MPC8245 writes parity bits to SDRAM. Note that this bit does not enable parity checking and generation. PCKEN must be set to enable parity checking. See Section 6.2.9, “SDRAM Parity and RMW Parity,” for more information. 0 RMW parity disabled 1 RMW parity enabled. Note that this bit must be set for SDRAM systems that use in-line ECC (MCCR4[BUF_TYPE[0–1]] = 0b10 and MCCR2[INLINE_PAR_NOT_ECC]] = 0).

4.12, 4-55 In Figure 4-35, “Memory Control Configuration Register 4 (MCCR4)—0xFC,” bit 21 should be the EXTROM field. Replace Figure 4-35 with the following:



4.12, 4-58 In Table 4-50, “Bit Settings for MCCR4—0xFC,” delete ‘flow through or’ from the first parenthesis sentence. The description should read as follows:

7–4	ACTORW	0000	Activate to read/write interval. These bits control the number of clock cycles from an SDRAM-activate command until an SDRAM-read or SDRAM-write command is allowed. See Section 6.2.4, “SDRAM Power-On Initialization,” for more information. 0001 Reserved 0010 2 clocks (minimum for registered data interfaces) 0011 3 clocks (minimum for in-line ECC/parity data interfaces) ... ... 1111 15 clocks 0000 16 clocks

5.5.2, 5-29 Add the following paragraph after the second paragraph “Although exception...instructions.”:

Note that the physical address of the hard reset vector is always 0xFFF0_0100. The exceptions are vectored to the physical address 0xFFF*n*_*nnnn* or 0x000*n*_*nnnn* depends on the setting of MSR[IP] where the default is 0xFFF*n*_*nnnn*.

6.1, 6-1 The second bullet ‘data-path buffering’ should not be a sub-bullet of Port X. The bullet should read as follows:

- Data-path buffering: 64-bits (64-bit data and 8-bit parity)
  - —Reduces loading on the internal processor core bus
  - —Reduces loading of the drivers of the memory system
  - —Reduces signal trace delay known as time-of-flight (TOF)

6.1, 6-4 — In Table 6-1, “Memory Interface Signal Summary,” footnote 1 should apply to **both** MDH[0:31] and MDL[0:31].

6.1, 6-4 — In Table 6-2, delete “TABLE 1” and place table title “Memory Address Signal Mappings,” before the table.

6.2.3, 6-15 — In Table 6-6, “Memory Data-Path Parameters,” the rows describing EDO and ECC_EN should be removed; the name INLRD_PARECC_CHK_EN should be replaced with the bit name INLINE_RD_EN; the name MEM_PARITY_ECC_EN should be replaced with bit name Memory parity/ECC enable; the name MB_ECC_ERR_EN should be replaced with ECC multi-bit error enable. Replace Table 6-6 with the following:

Bit Name	Register and Offset	Bit Number in Register
SDRAM_EN	MCCR1 @F0	17
PCKEN	MCCR1 @F0	16
INLINE_WR_EN	MCCR2 @F4	19
INLINE_RD_EN	MCCR2 @F4	18
INLINE_PAR_NOT_ECC	MCCR2 @F4	20
BUF_TYPE[0]	MCCR4 @FC	22
BUF_TYPE[1]	MCCR4 @FC	20
RMW_PAR	MCCR2 @F4	0
Memory parity/ECC enable	ErrEnR1 @C0	2
ECC multi-bit error enable	ErrEnR2 @C4	3

6.2.3, 6-15 — In Table 6-7, “SDRAM System Configuration,” the columns labeled EDO and ECC_EN should be removed; the column labeled RAM_TYPE should be labeled SDRAM_EN; the column labeled INLDRD_PARECC_CHK_EN should be labeled INLINE_RD_EN; the column labeled MEM_PARITY_ECC_EN should be labeled Memory Parity/ECC Enable; the column labeled MB_ECC_ERR_EN should be labeled ECC Multi-Bit Error Enable; the rows describing flow-through mode should be removed; and INLINE_WR_EN should be cleared in the last row. Replace Table 6-7 with the following:

SDRAM_EN	PCKEN	INLINE_WR_EN	INLINE_RD_EN	INLINE_PAR_NOT_ECC	BUF_TYPE[0]	BUF_TYPE[1]	RMW_PAR	Memory Parity/ECC Enable	ECC Multi-Bit Error Enable	Description
0	0	0	0	0	0	1	0	0	0	Registered, no ECC or parity
0	1	0	0	0	0	1	0	1	0	Registered buffer parity
0	1	0	0	0	0	1	1	1	0	Registered buffer RMW parity
0	0	0	0	0	1	0	0	0	0	In-line, no parity
0	0	1	1	1	1	0	0	1	0	In-line, parity enabled
0	0	1	1	1	1	0	1	1	0	In-line, RMW parity enabled
0	0	0	1	0	1	0	1	1	1	In-line, ECC enabled

6.2.3, 6-16 Figure 6-6, “SDRAM Flow-Through Memory Interface,” and the paragraph above the figure should be removed from this chapter.

6.2.5, 6-19 In Table 6-8, “MPC8245 SDRAM Interface Commands,” add the following two sentences as table footnotes:

Read [1]	1	0	1	0	1
Write [2]	1	0	0	0	1

[1] The MPC8245 does not support the read with autoprecharge command. SDMA10 is driven low during the $\overline{\text{SDCAS}}$ phase. For SDRAMs with 11 column bits, SDMA11 is used as the 11th column bit.

[2] The MPC8245 does not support the write with autoprecharge command. For SDRAMs with 11 column bits, SDMA11 is used as the 11th column bit.

6.2.8, 6-24 In Figures 6-10 through 6-15, $\overline{\text{CS}}$ should be asserted for an additional half clock. Replace Figures 6-10 through 6-15 with the following:

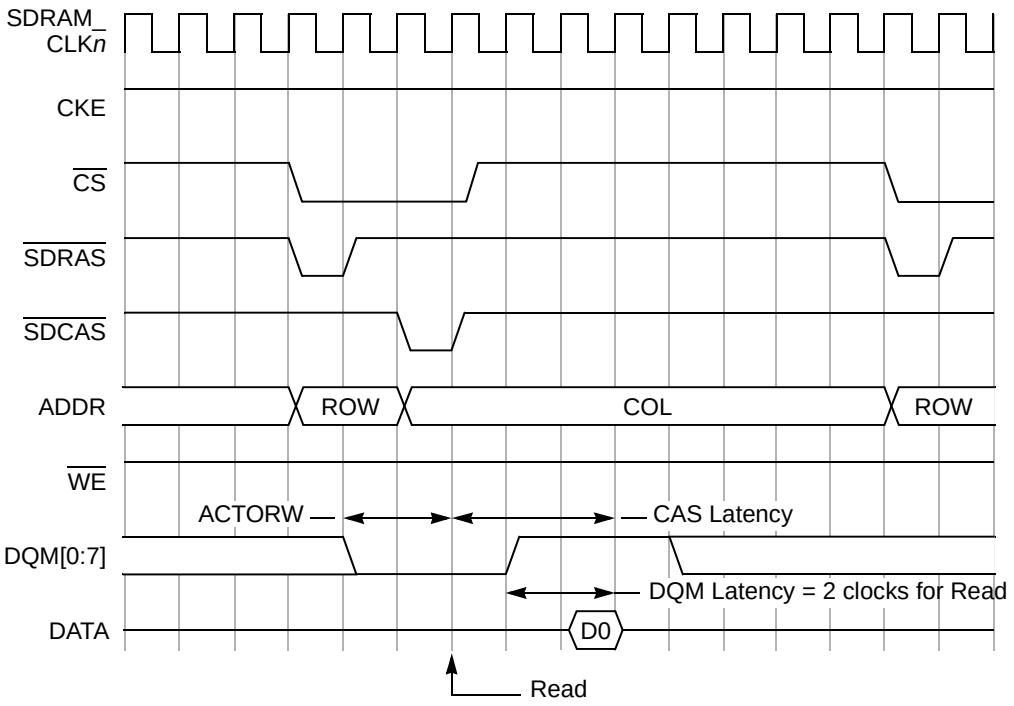


Figure 6-10. SDRAM Single-Beat Read Timing (SDRAM Burst Length = 4)

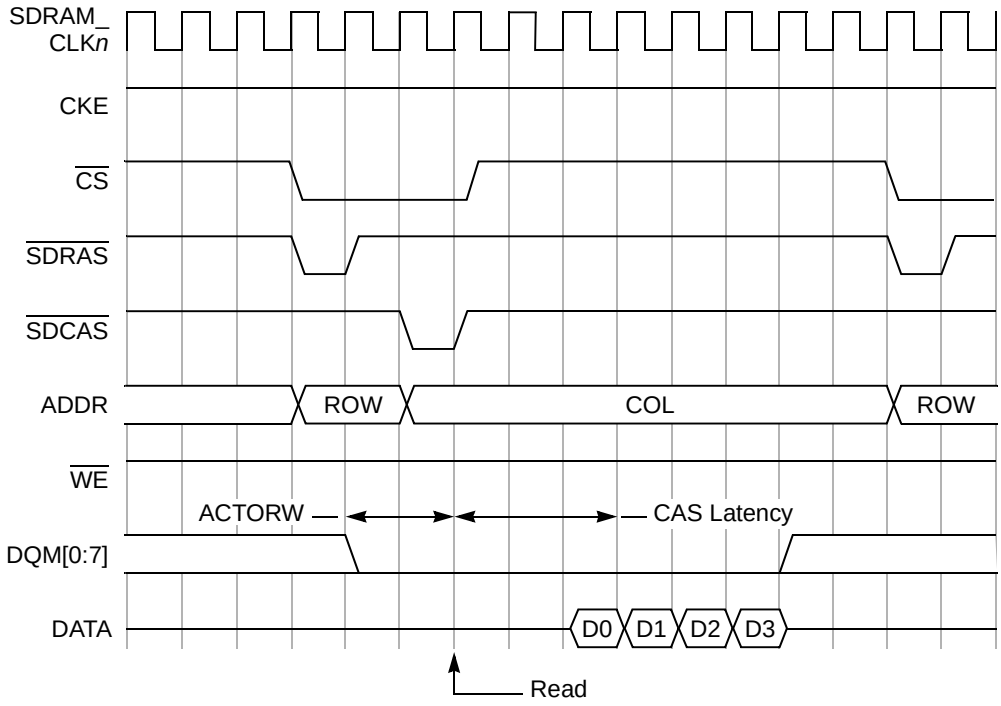


Figure 6-11. SDRAM Four-Beat Burst Read Timing Configuration—64-Bit Mode

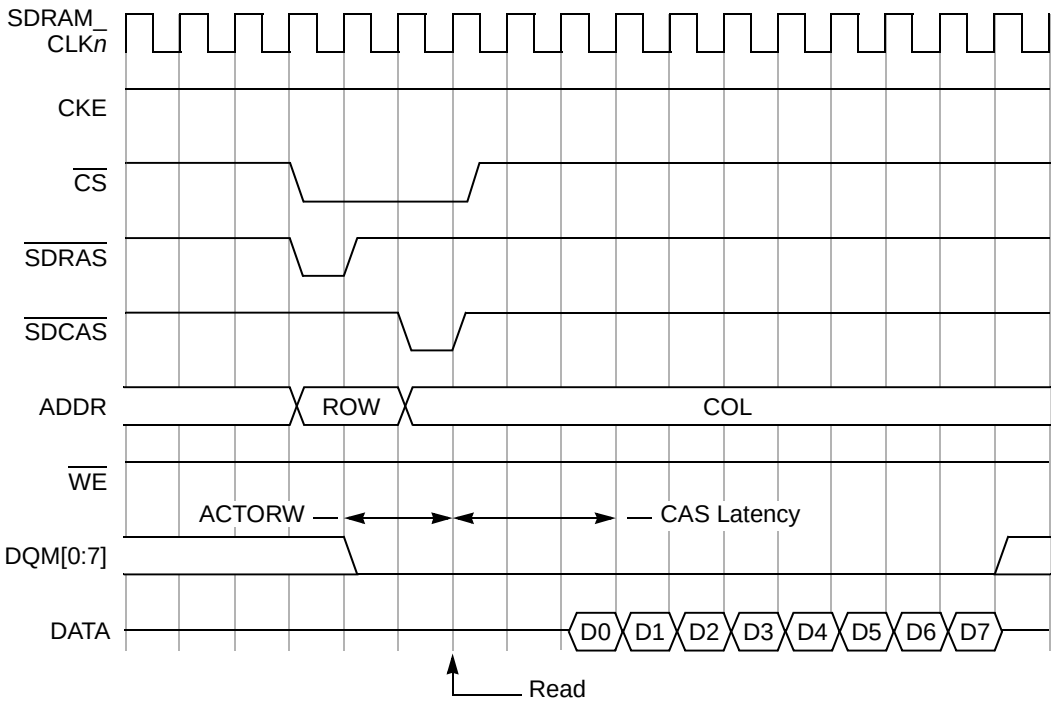


Figure 6-12. SDRAM Eight-Beat Burst Read Timing Configuration—32-Bit Mode

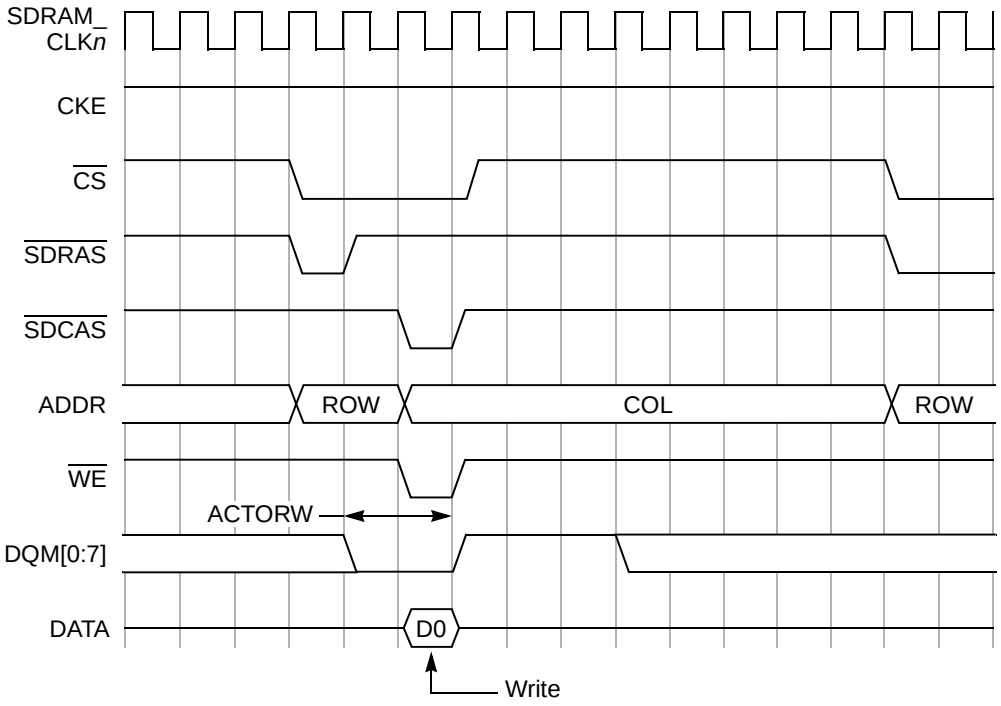


Figure 6-13. SDRAM Single-Beat Write Timing (SDRAM Burst Length = 4)

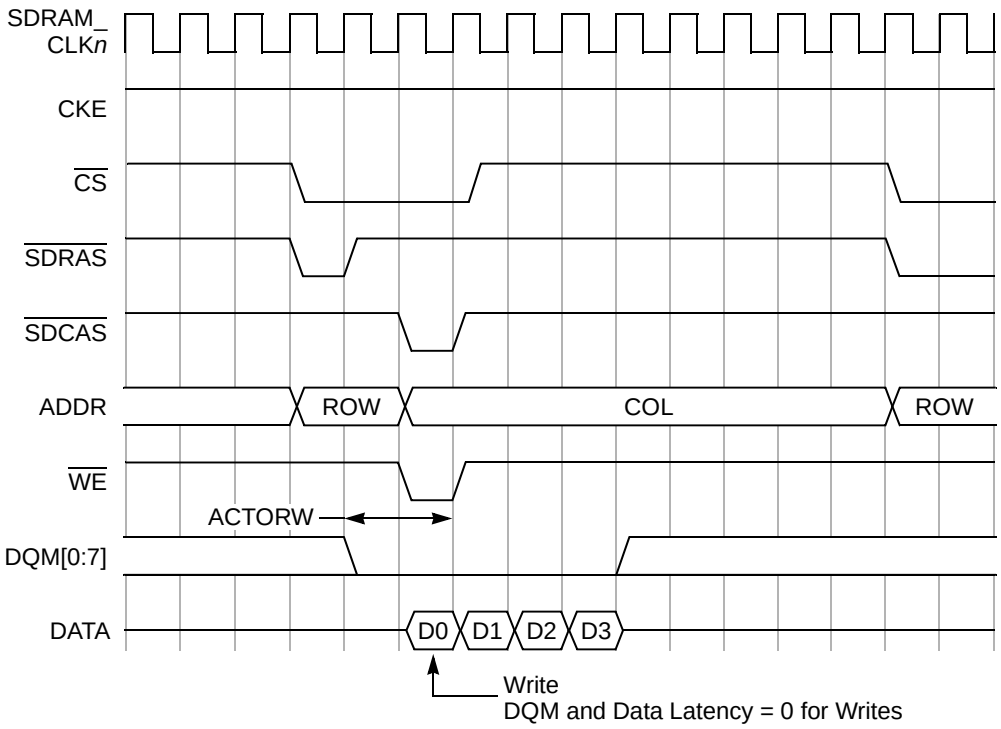


Figure 6-14. SDRAM Four-Beat Burst Write Timing—64-Bit Mode

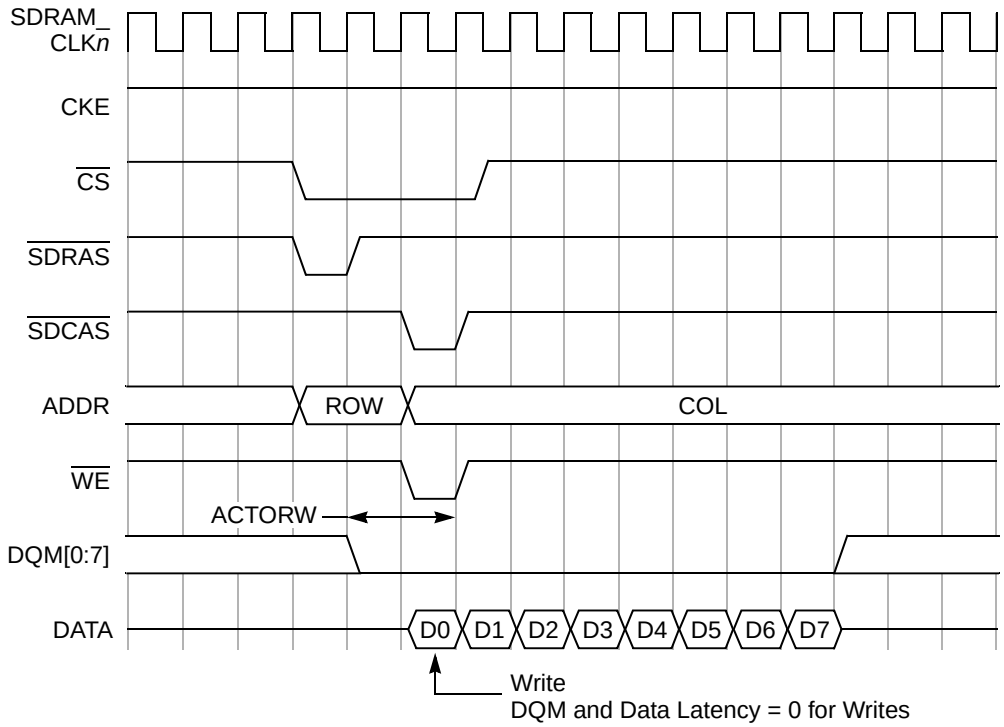


Figure 6-15. SDRAM Eight-Beat Burst Write Timing—32-Bit Mode

6.2.8.1, 6-27 In Figure 6-16, replace ‘Fixed at 5 clock cycles,’ with ‘At least 5 clock cycles.’

6.2.9, 6-28	Add the following sentence to the end of Section 6.2.9, “SDRAM Parity and RWM Parity:”
	Note that the MPC8245 does not support RMW parity mode when in 32-bit data path mode (RMW_PAR = 0).
6.2.10, 6-30	Add the following text to the end of Section 6.2.10, “SDRAM In-Line ECC:”
	Note that software must initialize the values of the ECC bits to accurate values. The following procedure may be used to initialize the ECC bits: 1. Clear MCCR1[MEMGO] and configure the memory size and timing parameters. 2. Turn on in-line ECC generation by setting the configuration parameters as described in Table 6-7. 3. Turn off ECC checking/error reporting by clearing the following: ECC single-bit trigger register (all bits of the register at 0xB9) —ErrEnR1[memory parity/ECC enable] (bit 2 of the register at 0xC0) —ErrEnR2[ECC multi-bit error enable] (bit 3 of the register at 0xC4) —MCCR2[INLINE_RD_EN] (bit 18 of the register at 0xF4) 4. Turn on the memory controller by setting MEMGO. 5. Perform a sequence of writes to all memory, causing the ECC generation logic to initialize all ECC bits. 6. Turn on ECC error checking/error reporting by setting the bits that were cleared in step 3 above.
6.2.12, 6-32	Replace the sixth sentence “When the refresh interval... counter is cleared.” of the first paragraph with the following: When the bus is idle, the MPC8245 performs all missed-refreshes back to back and the missed refresh counter is cleared.
6.3.1.1, 6-52	Replace “AR[22:21]” with “AR[22]” and ‘MCCR4[EXT_ROM] = 1’ with ‘SDMA1 = 1’ in the first sentence of the second paragraph. The sentence should read as follows: For Figure 6-34, note that AR[22] is only provided to the 8-bit base ROM interface if SDMA1 is sampled low at reset. See Section 6.3.1, “Base ROM Interface Operation,” for more information.

6.3.1.1, 6-52	Replace ‘MCCR4[EXT_ROM] = 1’ with ‘SDMA1 = 1’ in the first sentence of the second paragraph. The sentence should read as follows: For Figure 6-34, note that AR[22:21] are only provided to the 8-bit base ROM interface if SDMA1 = 1.
6.3.3, 6-57	In Section 6.3.3, “ROM/Flash Interface Write Operations,” add the following sentence after the third sentence of the first paragraph: Note that MCCR1[MEMGO] must be set before any writes to Flash are attempted.
6.3.3, 6-58	In Section 6.3.3, “ROM/Flash Interface Write Operations,” add the following paragraph before the first paragraph (third paragraph of the section): The MPC8245 accommodates only single-beat data path-sized (8-, 32-, or 64-bit depending on the configuration) writes to Flash memory. PICR1[NO_BUS_WIDTH_CHECK] controls whether the MPC8245 checks the data path size of processor writes to local base ROM space. If NO_BUS_WIDTH_CHECK is set, an attempt to write to Flash with a transfer size other than the base ROM data bus size (for example, a 32-bit write to an 8-bit Flash) does not cause a Flash write error. If NO_BUS_WIDTH_CHECK is cleared, an attempt to write to Flash with a transfer size other than the base ROM data bus size causes a Flash write error. If an attempt is made to write to Flash in extended ROM space with a transfer size other than the extended ROM data bus size, the MPC8245 does not report an error. In either of these two cases, if software is writing to Flash, the write operations should be sized to the data-path width (8, 16, 32, or 64 bits) because only a single write enable ($\overline{WE}$) strobe is available.
6.3.3, 6-58	In Section 6.3.3, “ROM/Flash Interface Write Operations,” delete the last paragraph.
6.3.4, 6-59	Third paragraph, last sentence, replace ‘but not for Port X... base ROM space.’ with ‘for handshake and strobe modes.’ The last sentence should read as follows: Note that the Flash write recovery timing is disabled for Port X devices in the extended ROM space for handshake and strobe modes.
6.3.4.1, 6-60, 6-61	In Figure 6-42, “Read Access Timing (Cache Block) for Burst ROM/Flash Devices—64-Bit (Wide) Data Path,” and Figure 6-43, “Read Access Timing (Cache Block) for Burst ROM/Flash

Devices—32-Bit (Wide) Data Path," notes 1 and 2 should be replaced with the following:

1.ROMFAL (ROM first access latency) = 0–31 clocks

2.ROMNAL (ROM nibble access latency) = 0–15 clocks

6.3.4.2, 6-62

Add the following paragraphs after Figure 6-46. Note that 'a:' represents actual data transactions and 'b' represents recovery.

1a) $\overline{\text{RCSn}}$ is asserted (low) for the 8 transfers needed to gather the first double word (8 bytes). The ROM address increments every ROMFAL + 2 cycles.

1b) $\overline{\text{RCSn}}$ is then negated (high) for 3 cycles for Registered Buffer Mode or 4 cycles for In-Line Buffer Mode

2a) $\overline{\text{RCSn}}$ is asserted for the 8 transfers needed to gather the second double word

2b) $\overline{\text{RCSn}}$ is then negated for 3 or 4 cycles depending on the buffer mode (as above in 1b)

3a) $\overline{\text{RCSn}}$ is asserted for the 8 transfers needed to gather the third double word

3b) $\overline{\text{RCSn}}$ is then negated for 3 or 4 cycles depending on the buffer mode (as above in 1b)

4a) $\overline{\text{RCSn}}$ is asserted for the 8 transfers needed to gather the fourth double word

4b) $\overline{\text{RCSn}}$ is then negated for 5 cycles for Registered Buffer Mode (3+2) or 7 cycles for In-Line Buffer Mode (4+3)

6.3.4.3, 6-63

In Figure 6-47, signals A[0:19] and DATA should be updated and $\overline{\text{CS}}$ should be renamed $\overline{\text{RCS}}$*n*. Also note that in this example, ROMFAL = 3 and ROMNAL = 1. Replace Figure 6-47 with the following:

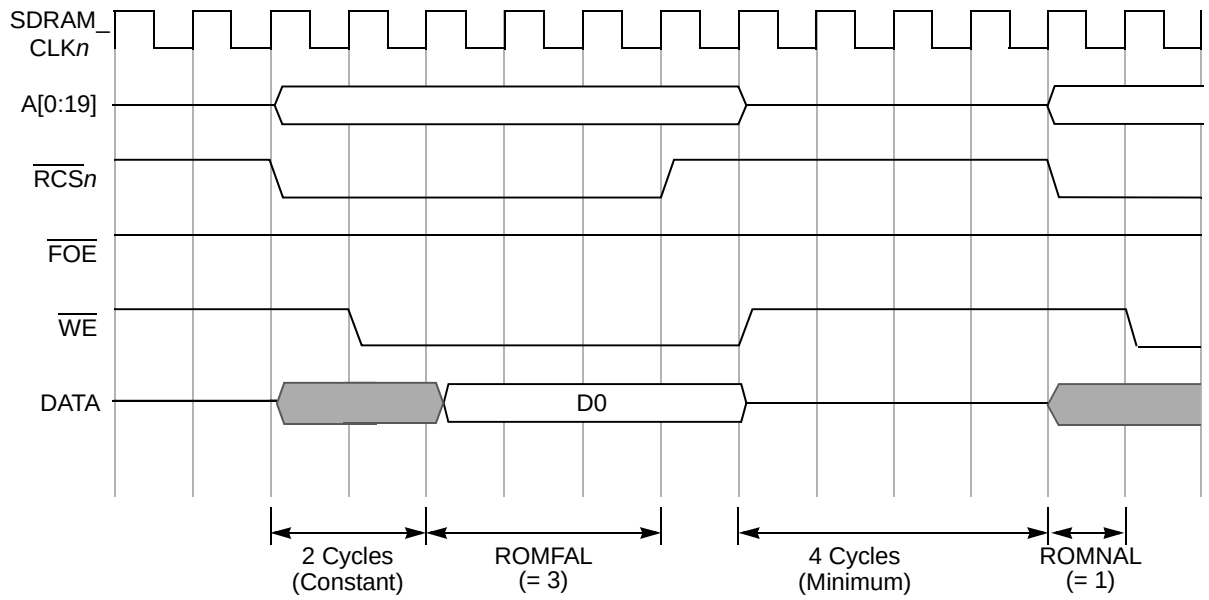


Figure 6-47. 8-, 32-, or 64-Bit Flash Write Access Timing

6.3.5.1, 6-65

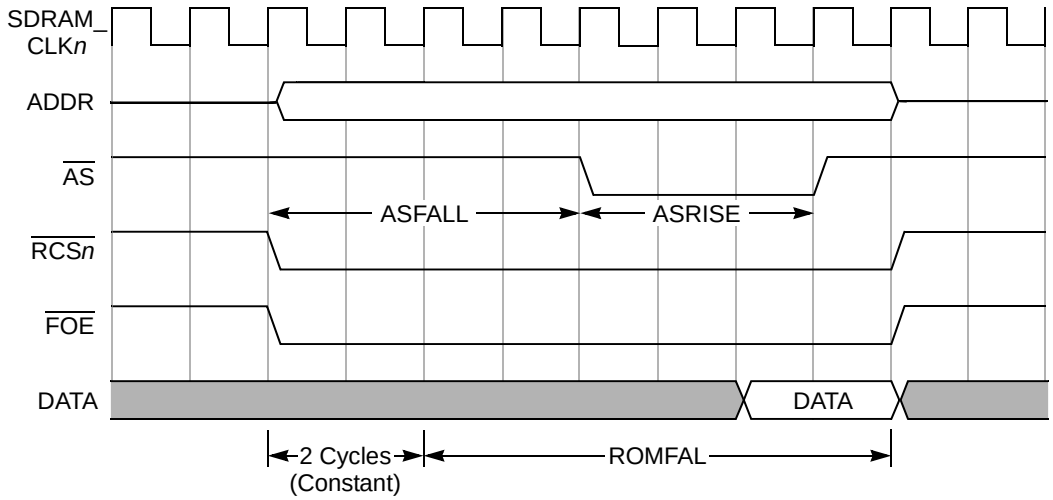
In Section 6.3.5.1, “Port X Operation,” add the following sentence before the second to last paragraph:

PCI masters should not attempt to read from Port X devices in handshake or strobe mode.

Also in Section 6.3.5.1, in the second to last paragraph, after the second sentence, add:

Also note that PCI reads from Port X are always bursts filling one of the PCI-to-local-memory-read buffers (PCMRB).

6.3.5.2, 6-67 In Figure 6-50, a note should be added and signals ADDR and DATA should be updated as follows:



Note: The data needs to be valid by end of the duration of ROMFAL + 2 clocks. The timing of data valid relative to the assertion of RCS*n* is dependent on the target device.

Figure 6-50. Port X Read Access Timing

6.3.5.2, 6-67 In Figure 6-51, signals ADDR and DATA should be updated as follows:

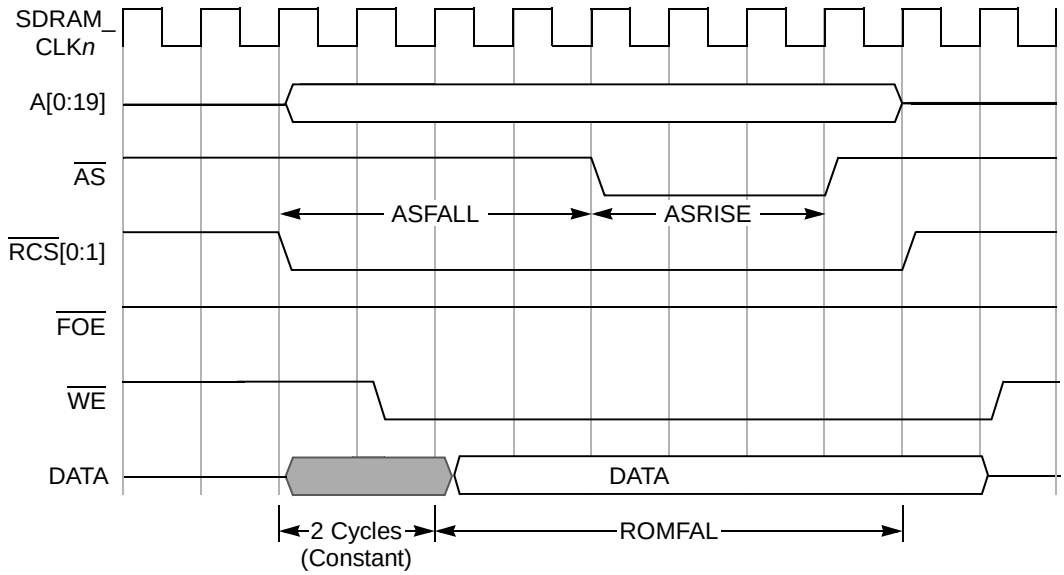


Figure 6-51. Port X Write Access Timing

6.3.5.2, 6-67 Replace the only paragraph (and the two-bulleted list items) after Figure 6-51, with the following paragraph:

The minimum negation times between Port X transactions are given in the appropriate TS_WAIT_TIMER description in Table 4-41,

Table 4-42, or Table 4-48. Note that these times are typically greater due to processor and CCU activity.

6.3.5.4, 6-69 — In Figure 6-53, the $\overline{WE}$ signal should be asserted and negated one clock cycle later as shown below:

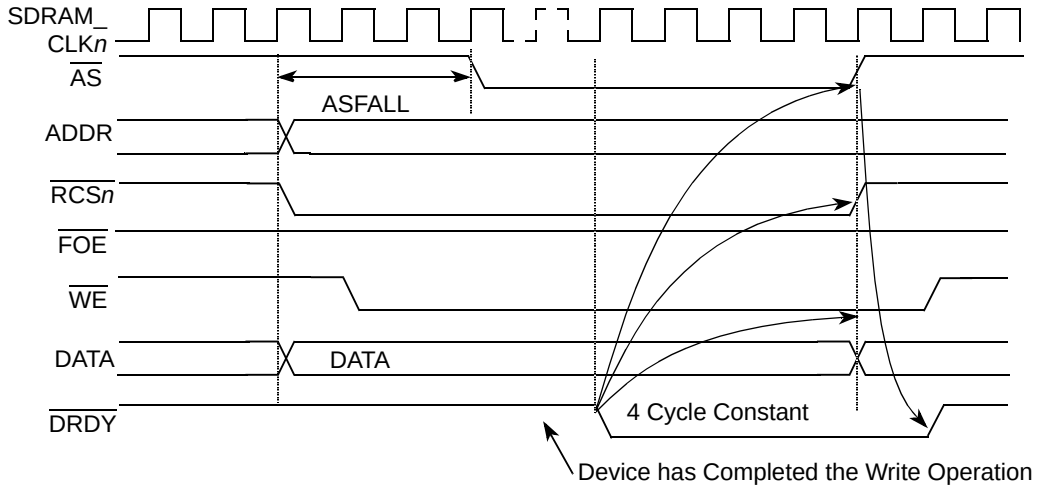


Figure 6-53. Port X Handshake Mode Write Timing

Chapter 7 — All references to address map A should be removed. MPC8245 does not support address map A.

Chapter 7 — All occurrences of “PCI compliance” should read as “PCI compatible.”

7.4.3.2.1, 7-19 — In Section 7.4.3.2.1, “Target Disconnect Termination,” the fourth bullet “The last 4 bytes...more information.)” should be removed because it does not cause a target disconnect.

7.4.6.2, 7-27 — In Section 7.4.6.2, “Accessing the PCI Configuration Space,” only the third sentence of the third paragraph (fourth paragraph of the section) applies to the MPC8245. Delete the rest of the paragraph and replace with the following:

The processor accesses the CONFIG_ADDR register at any location in the address range from 0xFEC0_0000 to 0xFEDF_FFFF. The format of CONFIG_ADDR is shown in Figure 7-13.

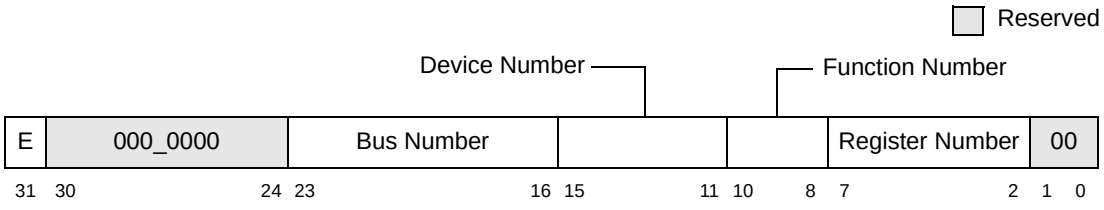


Figure 7-13. CONFIG_ADDR Register Format

7.4.6.2, 7-28	In Section 7.4.6.2, “Accessing the PCI Configuration Space,” only the third sentence of the first paragraph (after Table 7-6) applies to the MPC8245. Delete the rest of the paragraph and replace with the following: The processor accesses the CONFIG_DATA register at any location in the address range from 0xFEE0_0000 to 0xFEEF_FFFF. Note that the CONFIG_DATA register may contain 1, 2, 3, or 4 bytes depending on the size of the register being accessed.
7.4.6.2.1, 7-30	The first paragraph after Table 7-7, “Type 0 Configuration—Device Number to IDSEL Translation,” does not apply to the MPC8245 and should be removed.
7.7.2, 7-37	The third paragraph in Section 7.7.2, “Accessing the MPC8245 Configuration Space,” does not apply to the MPC8245 and should be removed:
8.5.3.2, 8-12	The title of Section 8.5.3.2 should be, “Accesses to Outbound Memory Window that Overlaps 0xFE00_0000 – 0xFEEF_FFFF.”
8.6, 8-14	In Table 8-2, “DMA Descriptor Summary,” the cross reference in the description of ‘Next descriptor address,’ should read as follows: ..., this field is loaded into the NDAR as described in Table 8-12.
9.2, 9-2	Add the following sentence after the last sentence of the first paragraph: Note that OPQIM must be cleared to allow OPQI to generate an interrupt.
9.3.3.2.2, 9-8	Add the following sentence after the last sentence of the second paragraph: Note that OPQIM must be cleared to allow OPQI to generate an interrupt.
10.3.2, 10-10	Add the following paragraph after Table 10-5: In some cases, the programmed value for the serial bit clock frequency (SCL) does not match the measured value because of the effect of DFFSR (sampling rate for the digital filter). Both DFFSR and FDR affect the speed of SCL. It takes a total of six DFFSR intervals (three samples for high and three samples for low) on the SCL to detect the true state of the clock. When the high or low is detected, the FDR value phase (half a cycle) is counted as normal. The frequency that is actually observed is: $6 \times \text{DFFSR} + \text{FDR}$

	For instance, if FDR is set to 0x00 (divider = 288 in decimal) and DFFSR is set to 0x30 (divider = 48 in decimal), it takes 3×48 system clocks to detect the high edge. The high level is maintained for an additional 144 clocks to create the first phase of the programmed frequency. It takes 3×48 system clocks to detect a low. The low level is maintained for an additional 144 clocks to create the first phase of the programmed frequency. Thus, the programmed divider is twice the divider shown in Table 10-5: $(6 \times 48) + 288 = 288 + 288 = 576$ In this case, the frequency is halved because the divider is doubled. The DFFSR should be reduced to a much smaller value to account for the faster programmed frequency.
10.3.5, 10-13	The following sentence should be added to the beginning of Section 10.3.5, "I^2C Data Register (I2CDR):" In master mode, bits 7–1, I2CDR[DATA] comprise the destination slave address. Bit 0 indicates the direction of transfer, 0 being master transmission and 1 being master reception.
10.4.1, 10-14	In step 3 of Section 10.4.1, "Initialization Sequence," change 'I2CFDR[FDR]' to 'I2CFDR.'
10.4.2, 10-15	The last sentence of step 3 should state the following: I2CDR[0] indicates the direction of transfer (0 indicates transmit/1 indicates receive) required from the slave.
10.4.8, 10-18	Figure 10-8, should be updated. A block that states 'Clear I2CCR[TXAK],' should be placed after the 'Generate STOP' block and before the EOI in the box labeled 'Master Xmit.'
11.8, 11-14	The first item under step 6 of the initialization sequence should state: Load counter with FRR[NIRQ].
11.9.8.4, 11-28	The title of Table 11-26 should be: "EUMBBAR Offsets for IIDRs."
12.4.13, 12-25	In Figure 12-16, "DMA Status Register (UDSR)," the fields TXRDY and RXRDY should be switched so that bit 1 is TXRDY and bit 0 is RXRDY.
13.1.3, 13-6	There are "eight" data buffers for PCI accesses instead of "four." Replace the first sentence of the first paragraph with the following: The eight data buffers for PCI accesses to local memory—up to four 32-byte PCI-to-local memory read buffers (PCMRBs) for PCI reads

from local memory and up to four 32-byte PCI-to-local memory write buffers (PCMWBs) for PCI writes to local memory.

Also, replace Figure 13-4, “PCI/Local Memory Buffers,” with the following and add the following paragraph after this figure:

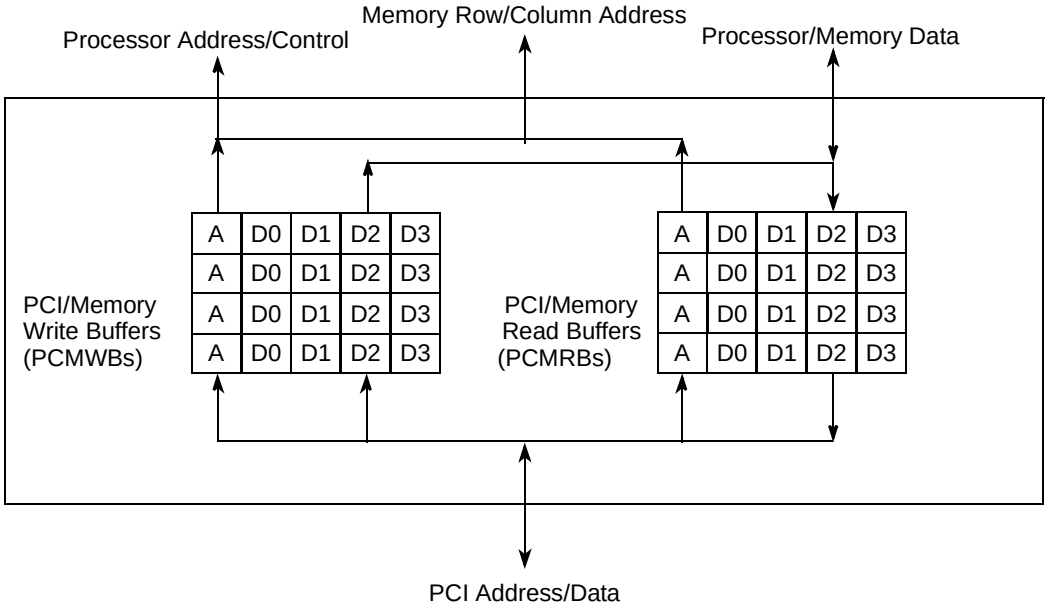


Figure 13-4. PCI/Local Memory Buffers

The number of buffers available is determined by PCI/Memory buffer configuration register. See Section 4.11, “PCI/Memory Buffer Configuration Register—0xE1,” for more information.

13.1.3.2, 13-8 Replace the first sentence of the first paragraph with the following:

For PCI-write transactions to local memory, the MPC8245 employs up to four PCMWBs.

13.1.3.2, 13-8 Replace the last two sentences of the first paragraph with the following:

Also, four buffers allow a PCI master to write to one buffer while an other buffer is flushing its contents to local memory. The PCMWBs are capable of gathering for writes to the same cache line.

13.1.3.2, 13-9 Replace the first sentence of the first paragraph of this page (third paragraph of this section) with the following:

A PCI transaction that hits in a PCMWB does not require a snoop on the peripheral logic bus.

13.1.3.2, 13-9 Replace the last sentence of the last paragraph of this section with the following:

	If valid data is in all available buffers, further gathering is not supported until one of the buffers is flushed.
14.3, 14-5	Replace the last sentence of the first paragraph with the following: (The error detection bits are specifically bits 15, 13, and 12 in the PCI status register; bits 7–0 in the ErrDR1; bits 7, 6, 3, 2, and 0 in ErrDR2; and bits 8, 7, and 4 in the IMISR.)
14.3.1.1, 14-6	The text referring to map A should be removed. Replace the second sentence as follows: Unsupported processor bus transactions include writes to the PCI interrupt-acknowledge space (0xFEFn_nnnn) and attempts to execute the graphic read or graphic write instructions (**eciwx** or **ecowx**).
14.3.1.2, 14-7	The last paragraph of this section should be replaced with the following paragraph: Software must partition larger data into individual data path-sized (8-, 32-, or 64-bit) write operations. Note that PICR1[NO_BUS_WIDTH_CHECK] controls whether the MPC8245 checks the data path size of processor writes to local base ROM space. If NO_BUS_WIDTH_CHECK is set, an attempt to write to Flash with a transfer size other than the base ROM data bus size (for example, a 32-bit write to 8-bit Flash) does not cause a Flash write error. If NO_BUS_WIDTH_CHECK is cleared, an attempt to write to Flash with a transfer size other than the base ROM data bus size causes a Flash write error.
14.3.1.3, 14-7	Bit 19 of the MCCR2 register should be called “INLINE_WR_EN” instead of “WRITE_PAR_CHK.” Therefore replace the first sentence of the first paragraph with the following: When both ErrEnR2[2] and MCCR2[INLINE_WR_EN] are set, the MPC8245 checks processor parity on memory write cycles with the stipulations described in Table 14-2.
14.3.2.4, 14-9	In the second sentence of this section, ErrDR1[3] should be replaced with ErrDR1[4] as follows: When the MPC8245 detects a refresh overflow, ErrDR1[4] is set.
16.3.2, 16-12	In Table 16-6, “Command Type 1—Event Encodings,” Event 119, should be reserved.

16.4, 16-16 — Any reference to the RTC signal should be removed, including Sections 16.4, 16.4.1, 16.4.1.1, 16.4.1.2, and Table 16-7. RTC is a test input, *reserved for factory use only.*

17.4.1, 17-12 — In Figure 17-11, "Example ROM Debug Address, $\overline{\text{MIV}}$, and MAA Timings For Burst Read," notes 1 and 2 should be replaced with the following:

1.ROMFAL = 0–31 clocks

2.ROMNAL = 0–15 clocks

17.5, 17-13 — The first sentence of the second paragraph should state:

The memory data-path error injection/capture system is programmed via the six memory data-path diagnostic registers and the WP_CONTROL register.

Also, the following sentence should be added before the last sentence of this section:

Note that WP_CONTROL[WP_DATC] must equal 0b10 to enable memory data-path error injection/capture.

18.3.4, 18-9 — In Figure 18-11, "Watchpoint Control Register (WP_CONTROL)—Offsets 0xF_F048, 0xF48," bits 26–25, 23–20, and 15–12 should be 'reserved.' Replace the Figure 18-11 with the following:

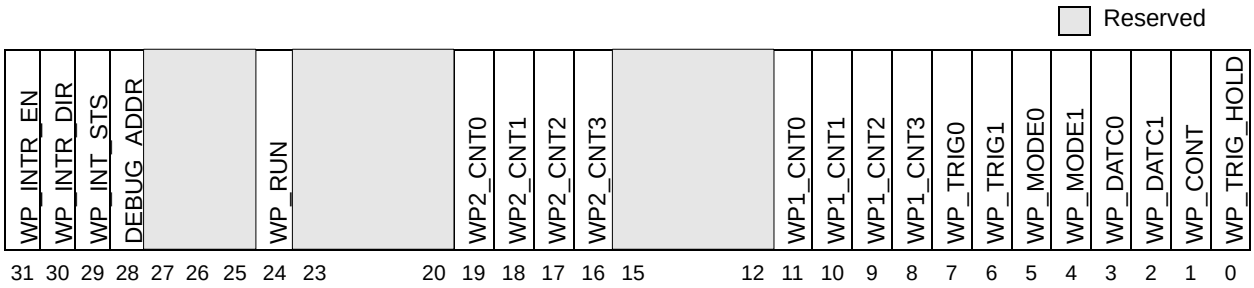


Figure 18-11. Watchpoint Control Register (WP_CONTROL)—Offsets 0xF_F048, 0xF48

18.3.4, 18-10 — In Table 18-7, "Watchpoint Control Register Bit Field Definitions," bit 27 should be named WP_MODE[2].

The bit settings for WP_CONTROL[WP_RUN], bit 24, should be reversed. A watchpoint scan is stopped when WP_RUN is cleared, and started when WP_RUN is set.

The description for WP_CONTROL[WP_TRIG[0–1]], bit setting 0b11, should add the requirement to set bit 6 before setting bit 7.

When WP_CONTROL[WP_DATC]] is equal to 0b10, memory data-path error injection/capture is enabled.

27	WP_MODE[2]	0	R/W	Defines operation modes. See Table 18-8.

24	WP_RUN	0	R/W	The watchpoint run bit is used to start and stop a watchpoint scan. This is the only watchpoint register bit that should be changed by software while the watchpoint facility is enabled (WP_RUN = 1). This bit can also be toggled externally by pulsing the TRIG_IN signal if the watchpoint facility is not in the HOLD state. When the watchpoint facility is in the HOLD state, pulsing TRIG_IN causes the watchpoint facility to wake up and continue or conclude its scan as programmed. 0 Stop a watchpoint scan 1 Start a watchpoint scan

7–6	WP_TRIG[0–1]	0b00	R/W	The watchpoint trigger control field is used to select the driver modes of the TRIG_OUT signal as follows: 0x TRIG_OUT is disabled; TRIG_OUT is in high-impedance state. 10 TRIG_OUT is enabled as an active high output 11 TRIG_OUT is enabled as an active low output. Note that to enable TRIG_OUT as active low, bit 6 must be set before bit 7.

3–2	WP_DATC[0–1]	0b00	R/W	The WPM data capture control field is used to define the data capture modes of the watchpoint monitor. Supported functions are the following: 00 Do not capture 60x data bus 01 Capture 60x data bus on the C_1th trigger match: T_1 while in single or waterfall mode T_1 or T_2 while in OR mode T_1 and not T_2 while in AND NOT mode 10 Enable memory data-path error injection/capture. 11 Capture 60x data bus on the C_2th trigger match: T_2 while in waterfall mode Not applicable while in single, OR, and AND NOT modes

Appendix B, B-1 In Appendix B, replace all code with new code. See Appendix B for more information.

Appendix D, D-26 In Table D-20, “HID0 Field Descriptions,” the description for ICFI (bit 20) and DCFI (bit 21) should read as follows:

20	ICFI	Instruction cache flash invalidate [2] 0 The instruction cache is not invalidated. The bit is cleared when the invalidation operation begins (usually the next cycle after the write operation to the register). The instruction cache must be enabled for the invalidation to occur. 1 An invalidate operation is issued that marks the state of each instruction cache block as invalid without writing back modified cache blocks to memory. Cache access is blocked during this time. Accesses to the cache from the peripheral logic bus are signaled as a miss during invalidate-all operations. Setting ICFI clears all the valid bits of the blocks and the PLRU bits to point to way L0 of each set. For MPC603e processors, the proper use of the ICFI and DCFI bits is to set them and clear them with two consecutive **mtspr** operations.
21	DCFI	Data cache flash invalidate [2] 0 The data cache is not invalidated. The bit is cleared when the invalidation operation begins (usually the next cycle after the write operation to the register). The data cache must be enabled for the invalidation to occur. 1 An invalidate operation is issued that marks the state of each data cache block as invalid without writing back modified cache blocks to memory. Cache access is blocked during this time. Accesses to the cache from the peripheral logic bus are signaled as a miss during invalidate-all operations. Setting DCFI clears all the valid bits of the blocks and the PLRU bits so that they point to way L0 of each set. For MPC603e processors, the proper use of the ICFI and DCFI bits is to set them and clear them with two consecutive **mtspr** operations.

Glossary of Terms and Abbreviations

The glossary contains an alphabetical list of terms, phrases, and abbreviations used in this book. Some of the terms and definitions included in the glossary are reprinted from IEEE Std 754-1985, IEEE Standard for Binary Floating-Point Arithmetic, copyright ©1985 by the Institute of Electrical and Electronics Engineers, Inc. with the permission of the IEEE.

A

Atomic. Bus access that attempts to be part of a read-write operation to the same address uninterrupted by any other access to that address (that is, the transactions are indivisible). The MPC603e microprocessor initiates the read and write separately, but signals the memory system that it is attempting an atomic operation. If the operation fails, status is kept so that the MPC603e can try again. The MPC603e implements atomic accesses through the **lwarx**/**stwcx.** instruction pair.

B

Beat. Single state on the MPC603e bus interface that may extend across multiple bus cycles. A MPC603e transaction can be composed of multiple address or data *beats*.

Big-endian. Byte-ordering method in memory where the address *n* of a word corresponds to the most significant byte. In an addressed memory word, the bytes are ordered (left to right) 0, 1, 2, 3, with 0 as the most significant byte.

Burst. Multiple beat data transfer whose total size is typically equal to a cache block (in the MPC603e, a 32-byte block).

Bus clock. Clock that causes the bus state transitions.

Bus master. Owner of the address or data bus; the device that initiates or requests the transaction.

C

Cache. High-speed memory containing recently accessed data or instructions (subset of main memory).

Cache block. Cacheable unit for a processor that implements the PowerPC architecture. The size of a cache block may vary among processors. For the MPC603e, it is one cache line (8 words).

Cache coherency. Caches are coherent if a processor performing a read from its cache is supplied with data corresponding to the most recent value written to memory or to another processor's cache.

Cast-outs. Cache block that must be written to memory when a snoop miss causes the least recently used block with modified data to be replaced.

Context synchronization. Context synchronization is the result of specific instructions (such as **sc** or **rfi**) or when certain events occur (such as an exception). During context synchronization, all instructions in execution complete past the point where they can produce an exception; all instructions in execution complete in the context in which they began execution; all subsequent instructions are fetched and executed in the new context.

Copy-back operation. Cache operation in which a cache line is copied back to memory to enforce cache coherency. Copy-back operations consist of snoop push-out operations and cache cast-out operations.

D

Denormalized number. Nonzero floating-point number whose exponent has a reserved value, usually the format's minimum, and whose explicit or implicit leading significand bit is zero.

Direct-store segment access. Access to an I/O address space. The MPC603 defines separate memory-mapped and I/O address spaces, or segments, distinguished by the corresponding segment register T bit in the address translation logic of the MPC603. If the T bit is cleared, the memory reference is a normal memory-mapped access and can use the virtual memory management hardware of the MPC603. If the T bit is set, the memory reference is a direct-store access.

E

E**xception**. Unusual or error condition that the processor encounters. The condition causes special processing.

Exception handler. Software routine that executes when an exception occurs. Normally, the exception handler corrects the condition that caused the exception or performs some other meaningful task (such as ending the program that caused the exception). The addresses of the exception handlers are defined by a two-word exception vector that is branched to automatically when an exception occurs.

Exclusive state. EMI state (E) in which only one caching device contains data that is also in system memory.

Execution synchronization. All instructions in execution are architecturally complete before beginning execution or appearing to begin execution of the next instruction. Similar to context synchronization but does not force the contents of the instruction buffers to be deleted and refetched.

F

Flush. Operation that causes a modified cache block to be invalidated and the data to be written to memory.

I

Instruction queue. Holding place for instructions fetched from the current instruction stream.

Integer unit. Functional unit in the MPC603e that is responsible for executing all integer instructions.

Interrupt. External signal that causes the MPC603e to suspend current execution and take a predefined exception.

Invalid state. EMI state (I) that indicates that the cache block does not contain valid data.

K

Kill. Operation that causes a cache block to be invalidated.

L

Latency. Number of clock cycles necessary to execute an instruction and make ready the results of that instruction.

Little-endian. Byte-ordering method in memory where the address *n* of a word corresponds to the least significant byte. In an addressed memory word, the bytes are ordered (left to right) 3, 2, 1, 0, with 3 as the most significant byte.

Low-drop-out.Term used to describe linear power supplies that supply a stable output even when the V_{in}-V_{out} difference is low.

M

Memory-mapped accesses. Accesses whose addresses use the segmented or block address translation mechanisms that the MMU provides and that occur externally with the bus protocol defined for memory.

Memory coherency. Refers to memory agreement between caches and system memory (for example, EMI cache coherency).

Memory consistency. Refers to levels of memory with respect to a single processor and system memory (for example, on-chip cache, secondary cache, and system memory).

Memory-forced I/O controller interface access. Accesses made to memory space. They do not use the extensions to the memory protocol described for I/O controller interface accesses, and they bypass the page- and block-translation and protection mechanisms.

Memory management unit. Functional unit in the MPC603e that translates the logical address bits to physical address bits.

Modified state. EMI state (M) in which one, and only one, caching device has the valid data for that address. The data at this address in external memory is not valid.

O

Out-of-order. Operation is said to be out-of-order when it is not guaranteed to be required by the sequential execution model, such as the execution of an instruction that follows another instruction that may alter the instruction flow. For example, execution of instructions in an unresolved branch is said to be out-of-order, as is the execution of an instruction behind another instruction that may yet cause an exception. The results of operations that are performed out-of-order are not committed to architected resources until it can be ensured that these results adhere to the in-order, or sequential execution model.

P

Page.4-Kbyte area of memory, aligned on a 4-Kbyte boundary.

Park. Act of allowing a bus master to maintain mastership of the bus without having to arbitrate.

Pipelining. Technique that breaks instruction execution into distinct steps so that multiple steps can be performed at the same time.

Q

Quiesce. To come to rest. The processor is said to quiesce when an exception is taken or a **sync** instruction is executed. The instruction stream is stopped at the decode stage and executing instructions are allowed to complete to create a controlled context for instructions that may be affected by out-of-order, parallel execution. See **Context synchronization**.

S

Scan interface. MPC603e test interface.

Slave. Device that a master device addresses. The slave is identified in the address tenure and is responsible for supplying or latching the requested data for the master during the data tenure.

Snooping. Monitoring addresses that a bus master drives. They detect need for coherency actions.

Snoop push. Write-backs due to a snoop hit. The block transitions to an invalid or exclusive state.

Split-transaction. Transaction with independent request and response tenures.

Split-transaction Bus. Bus that allows address and data transactions from different processors to occur independently.

Superscalar machine. Machine that can issue multiple instructions concurrently from a conventional linear instruction stream.

Supervisor mode. Privileged operation state of the MPC603e. In supervisor mode, software can access all control registers and can access the supervisor memory space, among other privileged operations.

T

Tenure. Period of bus mastership. The MPC603e has separate address bus tenures and data bus tenures. A tenure consists of three phases: arbitration, transfer, termination.

Transaction. Complete exchange between two bus devices. A transaction is minimally comprised of an address tenure, and one or more data tenures could be involved in the exchange. The two kinds of transactions are address/data and address-only.

Transfer termination. Signal that refers to both signals that acknowledge the transfer of individual beats (of both single-beat transfer and individual beats of a burst transfer) and to signals that mark the end of the tenure.

U

User mode. Unprivileged operating state of the MPC603e. In user mode, software can access only certain control registers and only certain user memory space. Privileged operations cannot be performed.

W

Write-through. Memory update policy in which all processor write cycles are written to both the cache and memory.

Index

Numerics

603e core, *see* Processor core

A

Abbreviations, xlviii
Acronyms, xlviii
Address maps
  addressing on PCI bus, 7-12
  debug address maps, 17-7
  DMA controller interactions, 8-11
    agent mode, 8-12
    host mode, 8-11
  EUMB (embedded utilities memory block), 3-25
    registers
      peripheral control and status, 3-27, 3-29
      run-time, 3-25
  map B
    PCI I/O master view, 3-3
    PCI memory master view in agent mode, 3-3
    processor view in host mode, 3-2, 3-8
  map B overview, 3-1
  overview, 3-1
  PIC unit, 11-3
Addressing
  address translation registers, 3-19
  effective calculation, 5-19
  EUMB (embedded utilities memory block), 3-25
  inbound PCI address translation, 3-12
  modes, 5-19
  outbound PCI address translation, 3-16
  PCI bus
    addressing, 7-13
    configuration space, 7-13
    I/O space, 7-13
    memory space, 7-12
AD*n* (PCI address/data bus) signals, 2-10, 7-13
Agent mode, PCI address translation, 7-37
Alignment of bytes, 7-14, A-2
Arbitration
  I^2C arbitration procedure, 10-6
    arbitration loss, 10-6
  internal arbitration
    in-order execution, 13-9
    out-of-order execution, 13-1
  PCI bus arbitration, 7-4
AR*n* (ROM address) signals, 2-22
$\overline{AS}$ (address strobe) signal, 2-24, 2-25, 4-44, 4-47, 4-58

B

BAT registers, *see* Block address translation
BCR (byte count) register, 8-27
Big-endian mode
  accessing configuration registers, 4-3
  byte lane translation, A-2
  byte ordering, A-2
  DMA descriptors, 8-16
  LE_MODE bit, 4-32
  PCI memory space, A-3, A-5
BIST (built-in self test) control register, 4-10
Block address translation
  BAT registers
    BAT area lengths
Block address translation. BAT registers, D-17
Block diagrams
  clock subsystem block diagram, 2-39
  DMA controller, 8-2
  memory interface, 6-3
  MPC8240 functional block diagram, 1-2
  MPC8240 integrated processor core, 1-11
  peripheral logic block diagram, 1-15
  PIC controller, 11-3
  PIC unit internal block diagram, 11-9
  Port X interface, 6-67
  processor core, 5-2
  SDRAM interface, 6-6
BO operand encodings, D-10
Boundary-scan registers, 17-21
Branch instructions
  BO operand encodings, D-10
  condition register logical, C-24
  system linkage, C-24
  trap, C-24
Buffers
  internal buffers
    copy-back buffer, 13-2

PCI/local memory buffers, 13-6
PCI-to-local-memory-read (PCMRBs), 13-7
PCI-to-local-memory-write (PCMWBs), 13-8
processor-to-PCI-read buffer (PRPRB), 13-4
Burst operations
PCI bus transfer, 7-9
Burst ordering, PCI linear incrementing, 7-12
Bus interface
PCI bus arbitration unit, 1-17
peripheral logic, 1-12, 5-9
ratios, 1-21
Bus operations
PCI bus transactions, *see* PCI interface
Bypass register, 17-21
Byte
alignment, 7-14, A-2
byte enable signals, 2-11, 7-13, 7-14
ordering
big-endian mode, A-2
little-endian mode, A-6
mechanisms, A-1
most-significant byte/bit (MSB/msb), A-1
PCI bus, 7-2, A-1
processor bus, A-1
PCI alignment, 7-14, A-2
Byte-reverse instructions, C-22

C

$\overline{\text{C/BE}}n$ (command/byte enable) signals, 2-11, 7-14, 7-34
Cache
cache management instructions, C-25
central control unit (CCU), 5-25
coherency, 5-25
implementation for processor core, 5-22
overview, 5-9
CDAR (current descriptor address) register, 8-23
CDCR (clock driver control) register, 4-21
Central control unit (CCU)
cache coherency, 5-25
overview, 13-1
Chaining mode, DMA controller, 8-14
CHKSTOP_IN (checkstop in), 2-31
CKE (SDRAM clock enable) signal, 2-23
CKO (test clock) signal, 2-38
Clocks
clock stretching, 10-7
clock subsystem block diagram, 2-39
clock synchronization, 2-41, 10-7
clocking method, 2-38
DLL operation and locking, 2-40
examples, 2-42
signal description, 2-36
signals *see* Signals, clock, 2-36
Commands
mode-set command, 6-28
PCI commands
$\overline{\text{C/BE}}n$ signals, 7-10
C/BE*n* signals, 2-11
encodings, 7-10
interrupt-acknowledge transaction, 7-30
PCI command register, 4-10
special-cycle command, 7-31
Compare instructions, C-18
Completion, PCI, 7-18
Configuration
configuration registers
accessing registers, 4-2-4-3
CONFIG_ADDR register, 7-27
CONFIG_DATA register, 7-27
ECC single-bit error registers, 14-8
error handling registers, 4-35
60x/PCI error address register, 4-42
bus error status register, 4-36
ECC single-bit error registers, 4-35
error detection registers, 4-37
error enabling registers, 4-36
PCI bus error status register, 4-41
processor bus error status register, 4-39
error status registers, 4-40
memory interface
memory bank enable registers, 4-29
memory boundary registers, 4-25-4-30
memory control configuration registers, 4-53
memory page mode register, 4-30
PCI registers, *see* Registers, PCI interface, 4-10, 7-26
power management registers, 4-18-4-20
processor bus error status registers, 7-34-7-35, 14-6
processor interface registers, 4-31
processor/PCI error address register, 14-6
reserved bits, 4-1
summary of registers, list, 4-4, 4-8
EUMB registers
local processor control and status, 3-27
peripheral control and status, 3-29
runtime, 3-25
PCI configuration cycles
configuration space header, 7-25
configuration space header summary, 4-9
type 0 and 1 accesses, 7-27
PCI space addressing, 7-13
Conventions, xlvii
CR (condition register)
CR0/CR1 field definitions, D-5
CR*n* field, compare instructions, D-5
$\overline{\text{CS}}n$ (SDRAM command select) signals, 2-18
CTR (count register), BO operand encodings, D-10

D

DA (debug address) signal, 2-34
DAR (destination address) register, 8-26
Data bus
  bus transaction errors, 14-7
  shared data bus, 13-2
  termination by TEA, 14-11
Data high error capture monitor register, 17-18
Data high error injection mask register, 17-16
Data low error capture monitor register, 17-18
DCMP and ICMP registers, D-22
Debug
  address
    attribute signals, 17-2
    maps, 17-7
    purpose, 17-6
  data path error injection/capture, 17-15
  data registers
    high error capture monitor, 17-18
    high error injection mask, 17-16
    low error capture monitor, 17-18
  features list, 1-24
  memory
    data path error capture monitor register, 17-18
  memory debug address, 1-24
  parity error capture monitor register, 17-19
  parity error injection mask register, 17-17
  PCI address attribute signals, 17-3
Decrementer interrupt, 15-2
Device drivers, posted writes, 13-5
DEVSEL (device select) signal, 2-12, 7-13
DH*n*/DL*n* (data bus) signals, 2-21
Disconnect, *see* Termination, 13-4
DMA controller, 1-18
  block diagram, 8-2
  coherency, 8-9
  descriptors
    big-endian mode, 8-16
    chaining mode, 8-14
    little-endian mode, 8-17
  local memory to local memory transfers, 8-11
  local memory-to-PCI, 8-10
  modes
    chaining, 8-6
    direct, 8-5
  operation, 8-4
  overview, 8-1
  PCI-to-local memory transfers, 8-10
  PCI-to-PCI transfers, 8-10
  transfer types, 8-10
DMA transfers
  local memory-to-local memory, 8-10
  local memory-to-PCI, 8-10
  PCI-to-local memory, 8-10
  PCI-to-PCI, 8-10
DMISS and IMISS registers, D-22
DMR (DMA mode) register, 8-18
Doorbell registers, 1-18, 9-2
Doze mode, 1-22
DQM*n* (SDRAM data qualifier) signals, 2-18
DSR (DMA status) register, 8-21

E

EAR (external access register), bit format, D-21
ECC single-bit error
  registers, 4-35, 14-8
EICR (interrupt configuration) register, 11-17
Embedded utilities memory block (EUMB)
  local processor control and status registers, 3-27
  peripheral control and status registers, 3-29
  runtime registers, 3-25
ErrDR1/ErrDR2 (error detection) registers, 4-37, 7-34
ErrEnR1/ErrEnR2 (error enabling) registers, 4-36
Error handling registers, 4-35
Error signals, *see* Errors
Errors
  bus error status registers, 4-40
  error detection registers, 4-37, 7-34
  error enabling registers, 4-36
  error handling
    overview, 14-1
    registers, 2-30, 4-35, 7-34, 14-4
  error reporting, 14-7
    address/data error, 14-10
    address/data parity errors, 7-20
    error detection registers, 4-37, 7-34
    errors within a nibble, 14-9
    Flash write error, 14-8
    master-abort transaction termination, 14-11
    nonmaskable interrupt, 14-12
    overflow condition, 4-37
    PCI bus, 7-34, 14-5
    PERR and SERR signals, 7-35, 14-5
    system memory errors, 14-9
    target-initiated termination, 7-18
    TEA and MCP signals, 2-30
    unsupported bus transaction error, 14-7
  error reporting signals, *see* Signals, system control, 2-31
  error status registers, 14-6
  overflow condition, 14-10
  PCI interface
    address
      data parity errors, 7-35
    error transactions, 7-34
  processor bus error status registers, 7-34

retry transactions, 7-19
SDRAM ECC, 6-29
target-abort error, 7-19
target-disconnect error, 7-19
Event selection
MMCR*n* registers, 16-5
Exceptions
bus errors, 2-30, 14-4
interrupt and error signals, 14-3
interrupt latencies, 14-13
interrupt priorities, 14-3
overview, 5-28
system reset exception, 14-3
Exclusive access, PCI, 7-32
Execution units, 5-7
External control instructions, C-26

F

Features lists
debug features, 1-24
I^2C interface, 10-1
PIC unit, 11-2
processor core, 5-4
Flash interface
write operations, 6-60
Floating-point model
arithmetic instructions, C-19
compare instructions, C-20
FE0/FE1 bits, D-15
floating-point unit overview, 5-7
FPR0–FPR31, D-4
FPSCR instructions, C-20
load instructions, C-23
move instructions, C-23
multiply-add instructions, C-20
rounding/conversion instructions, C-20
store instructions, C-23
$\overline{\text{FOE}}$ (flash output enable) signal, 2-24
FPR0–FPR31 (floating-point registers), D-4
FPSCR (floating-point status and control register)
bit settings, D-6
FPSCR instructions, C-20
$\overline{\text{FRAME}}$ signal, 2-13, 7-9
FRR (feature reporting) register, 11-15
Full-power mode, 1-22, 15-4

G

G2 core, *see* Processor core
GCR (global configuration) register, 11-16
$\overline{\text{GNT}}$ (PCI bus grant) signal, 2-9, 7-4
GPR0–GPR31 (general purpose registers), D-4
GTBCR (global timer base count) register, 11-22
GTCCR (global timer current count) register, 11-22
GTDR (global timer destination) register, 11-24
GTVPR (global timer vector/ priority) register, 11-23

H

Hard reset
configuration pins sampled, 2-43
HRST_CPU (hard reset (processor)), 2-29
HRST_CTRL (hard reset (peripheral logic)), 2-29
HASH1 and HASH2 registers, D-23
HID0 (hardware implementation-dependent 0) registers
description, 5-14, D-25
doze bit, 15-5
DPM enable bit, 15-4
nap bit, 15-6
HID1 (hardware implementation 1) register, 5-18, D-28
HID2 (hardware implementation 2) register, 5-18, D-29

I

I/O master view, 3-3
I^2C control signals, *see* Signals, 2-26
I^2C interface
arbitration loss, 10-6
arbitration procedure, 10-6
clock stretching, 10-7
clock synchronization, 10-7
data transfer, 10-5
features list, 10-1
handshaking, 10-7
operation, 10-4
overview, 1-19
programming guidelines, 10-15
programming model, 10-7
programming the I^2C interface, 10-15
registers
I2CCR, 10-11
I2CDR, 10-14
I2CFDR, 10-8
I2CSR, 10-13
signals, 10-2
slave address transmission, 10-4
start condition, 10-4
start generation, 10-16
stop condition, 10-6
system configuration, 10-2
I2CCR (I^2C control) register, 10-11
I2CDR (I^2C data) register, 10-14
I2CFDR (I^2C frequency divider) register, 10-8
I2CSR (I^2C status) register, 10-13
I_2O interface
I_2O specification, 1-19
IABR (instruction address breakpoint register), D-24
IACK (processor interrupt acknowledge) register, 11-29
IDSEL (ID select) signal, 2-17

IEEE 1149.1 specifications
specification compliance, 17-21
IFHPR (inbound free_FIFO head pointer) register, 9-17
IFQPR (inbound FIFO queue port) register, 9-12, 9-13
IFTPR (inbound free_FIFO tail pointer) register, 9-17
ILR (PCI interrupt line) register, 4-15, 4-16
IMIMR (inbound message interrupt mask) register, 9-16
IMISR (inbound message interrupt status) register, 9-13
Instructions
branch instructions, C-24
cache management instructions, C-25
condition register logical, C-24
external control, C-26
floating-point
arithmetic, C-19
compare, C-20
FPSCR instructions, C-20
load instructions, C-23
move instructions, C-23
multiply-add, C-20
rounding and conversion, C-20
store instructions, C-23
instruction timing overview, 5-35
instruction unit, 5-5
integer
arithmetic, C-17
compare, C-18
load, C-21
logical, C-18
multiple, C-22
rotate and shift, C-19
store, C-21
load and store
byte-reverse instructions, C-22
integer multiple instructions, C-22
string instructions, C-22
memory control, C-25
memory synchronization, C-22
PowerPC instruction set, 5-19
PowerPC instructions, list
form (format), C-27
function, C-17
legend, C-39
mnemonic, C-1
opcode, C-9
processor control, C-24
segment register manipulation, C-25
system linkage, C-24
TLB management instructions, C-25
trap instructions, C-24
$\overline{\text{INTA}}$ (interrupt request) signal, 2-17
Integer
arithmetic instructions, C-17
compare instructions, C-18
load instructions, C-21
logical instructions, C-18
multiple instructions, C-22
rotate and shift instructions, C-19
store instructions, C-21
Integer unit, 5-7
Interface
I_2O interface
IFHPR, 9-17
IFQPR, 9-12, 9-13
IFTPR, 9-17
IMIMR, 9-16
IMISR, 9-13
IPHPR, 9-18
IPTPR, 9-19
MUCR, 9-22
OFHPR, 9-19
OFQPR, 9-13
OFTPR, 9-20
OMIMR, 9-11
OPHPR, 9-21
OPTPR, 9-21
outbound free_list FIFO, 9-8
overview, 9-1
PCI configuration identification, 9-4
QBAR, 9-23
register summary, 9-5
JTAG interface
block diagram, 17-20
boundary-scan registers, 17-21
bypass register, 17-21
instruction register, 17-21
registers, 17-21
status register, 17-21
TAP controller, 17-21
memory interface
configuration registers, 4-25
ECC error, 14-9
errors within a nibble, 14-9
Flash write error, 14-8
overview, 1-15
physical memory, 14-10
read data parity error, 14-9
refresh overflow error, 14-10
registers, 4-25-4-30
select error, 14-10
signals, *see* Signals, 2-18
system memory, 14-9
PCI interface
address
translation, 7-37
address bus decoding, 7-12
address/data parity error, 14-10
address/data parity errors, 7-20

big-endian mode,four-byte transfer, A-3
burst operation, 7-9
bus
protocol, 7-9
bus arbitration, 7-4
bus arbitration unit, 1-17
bus commands, 7-10
bus error signals, 14-5
bus transactions, *see* PCI interface
byte alignment, 7-14, A-2
byte ordering, 7-2, A-1
C/BE*n* signals, 7-34
configuration cycles
configuration header, 7-25
type 0 and 1 accesses, 7-27
configuration space addressing, 7-13
data transfers, 7-9, 7-15, 7-36
error detection and reporting, 7-34, 14-5, 14-10
error transactions, 7-34
exclusive access, 7-32
fast back-to-back transactions, 7-21
I/O space addressing, 7-13
linear incrementing, 7-12
little-endian mode, *see* PCI interface, A-9
master-abort transaction termination, 14-11
master-initiated transaction termination, 7-18
memory space addressing, 7-12
MPC8245 as PCI bus master, 7-2
MPC8245 as PCI target, 7-3
nonmaskable interrupt, 14-12
overview, 1-16, 7-1
PCI commands, *see* PCI interface, PCI commands
PCI Local Bus Specification, xlv, 4-9
PCI System Design Guide, xlv
PCI/local memory buffers, 13-6
PCI-to-ISA bridge, 14-6
PCI-to-local memory read buffer (PCMRB), 13-7
PCI-to-local memory write buffers (PCMWBs), 13-8
processor-to-PCI-read buffer (PRPRB), 13-4
processor-to-PCI-write buffers (PRPWBs), 13-5
read transactions, 7-15
registers, *see* Registers, PCI interface
retry PCI transactions, 7-19
signals, *see* Signals, PCI interface
target-abort error, 7-19, 14-12
target-disconnect, 7-3, 7-19, 13-4
target-initiated termination, 7-20
transaction termination, 7-18
turnaround cycle, 7-14
write transactions, 7-17
processor interface
bus error signals, 14-4
byte ordering, A-1
configuration registers, 4-31
error detection, 14-7
error handling registers, 4-35
local memory buffer, 13-3
PCI buffers, 13-4
processor bus error status register, 14-6
programmable parameters
PICR1/PICR2 registers, 4-31
unsupported bus transactions error, 14-7
SDRAM interface
power-on initialization, 6-17
Internal control
arbitration
in-order execution, 13-9
out-of-order execution, 13-1
internal buffers, 13-1
Interrupt protocol, PIC unit, 11-7
IPHPR (inbound post_FIFO head pointer) register, 9-18
IPR (interrupt pending) register, 11-9
IPTPR (inbound post_FIFO tail pointer) register, 9-19
IRDY (initiator ready) signal, 2-14, 7-9
IRQ*n* (discrete interrupt), 2-25
IRR (interrupt request register) register, 11-10
IS (interrupt selector) register, 11-10
ISR (in-service) register, 11-10
ITWR (inbound translation window) register, 3-21

J

JTAG interface
block diagram of JTAG interface, 17-20
boundary-scan registers, 17-21
bypass register, 17-21
instruction register, 17-21
JTAG registers, 17-21
status register, 17-21
TAP controller, 17-21

L

Little-endian mode
accessing configuration registers, 4-2, 4-3
aligned scalars, address modification, A-6
byte lane translation, A-7
byte ordering, A-6
DMA descriptors, 8-17
LE_MODE bit, 4-32, A-6
PCI bus, A-1
PCI I/O space, A-12
PCI memory space, A-9
LMBAR (local memory base address) register, 3-20, 3-23, 4-15
Load/store
byte-reverse instructions, C-22
floating-point instructions

load, C-23
move, C-23
store, C-23
integer load instructions, C-21
integer store instructions, C-21
load/store multiple instructions, C-22
memory synchronization instructions, C-22
string instructions, C-22
Local processor control and status registers, *see* EUMB registers, 3-27
$\overline{\text{LOCK}}$ (lock) signal, 2-14

M

MAA (memory address attribute) signals, 2-33, 17-2
Master-abort termination, PCI, 7-18
Master-abort, PCI, 14-11
MCCR*n* (memory control configuration) registers, 4-53-4-59
$\overline{\text{MCP}}$ (machine check) signal, 2-30
Memory
synchronization instructions, C-22
Memory data path error capture monitor register, 17-18
Memory interface
address signal mappings, 6-4
block diagram, 6-3
configuration registers, *see* Registers, memory interface
ECC error, 14-9
errors within a nibble, 14-9
Flash write error, 14-8
memory attribute signals, 1-24
overview, 1-15, 6-1
physical memory, 14-10
Port X, 6-66
read data parity error, 14-9
refresh overflow error, 14-10
SDRAM interface, 6-6
select error, 14-10
signal summary, 6-3
signals, *see* Signals, 2-18
system memory, 14-9
Memory management unit (MMU), 5-9, 5-32
Memory, agent mode PCI address translation, 7-37
Message registers, *see* Registers
Message unit, 1-18
I_2O interface
hardware registers, 9-5
IFHPR, 9-17
IFQPR, 9-12, 9-13
IFTPR, 9-17
IMIMR, 9-16
IMISR, 9-13
inbound FIFOs, 9-7
IPHPR, 9-18
IPTPR, 9-19
MUCR, 9-22
OFHPR, 9-19
OFQPR, 9-13
OFTPR, 9-20
OMIMR, 9-11
OMISR, 9-9
OPHPR, 9-21
OPTPR, 9-21
outbound free_list FIFO, 9-8
overview, 9-1
PCI configuration identification, 9-4
QBAR, 9-23
register summary, 9-5
MICR*n* (memory interface configuration) registers, 4-25
MIV (memory interface valid) signal, 1-25, 17-10
Modes
DMA controller
chaining mode, 8-6
direct mode, 8-5
doze mode, 1-22
full-power mode, 1-22
nap mode, 1-22
PCI modes
agent mode, 3-3, 7-37
processor view in host mode, 3-2, 3-8
SDRAM register DIMM mode, 6-31
sleep mode, 1-22
MPC8240
differences with the processor core, 5-36
implementation-specific registers, 5-12, D-21
MMU features, 5-34
peripheral logic block diagram, 1-15
possible applications, 1-6
processor core block diagram, 5-2
processor core differences, 5-36
uses for the MPC8240, 1-6
MPC8245
MPC8245 as PCI bus master, 7-2
MPC8245 as PCI target, 7-3
MSR (machine state register)
FE0/FE1 bits, D-15
MUCR (messaging unit control) register, 9-22
Munging
definition, A-1
munged little endian mode, *see also* modified little-endian mode
munged memory image, LE mode, A-7

N

Nap mode
description, 1-22, 15-10

NDAR (next descriptor address) register, 8-28
NMI (nonmaskable interrupt) signal, 2-31, 14-6, 14-12

O

ODCR (output driver control) register, 4-21
OEA (operating environment architecture)
  register set, D-12
OFHPR (outbound free_FIFO head pointer) register, 9-19
OFQPR (outbound FIFO queue port) register, 9-13
OFTPR (outbound free_FIFO tail pointer) register, 9-20
OMBAR (outbound memory base address) register, 3-23
OMIMR (outbound message interrupt mask) register, 9-11
OMISR (outbound message interrupt status) register, 9-9
Operands
  BO operand encodings, D-10
OPHPR (outbound post_FIFO head pointer) register, 9-21
Optional instructions, C-39
OPTPR (outbound post_FIFO tail pointer) register, 9-21
OSC_IN (system clock input) signal, 2-37
OTWR (outbound translation window) register, 3-24
Overview
  processor core, 5-1

P

PAR (PCI parity) signal, 2-11, 7-34
Parity
  SDRAM interface
    parity, 6-28
    read-modify-write (RMW) parity, 6-28
Parity error capture monitor register, 17-19
Parity error injection mask register, 17-17
PAR*n* (data parity/ECC) signals, 2-22
PBCCR (PCI base class code) register, 4-14
PCI interface
  address
    bus decoding, 7-12
    translation, 7-37
  address map B
    PCI I/O master view, 3-3
    PCI memory master view in agent mode, 3-3
    processor view in host mode, 3-2, 3-8
  address map B overview, 3-1
  address/data parity errors, 7-20, 14-10
  big-endian mode, four-byte transfer, A-3
  burst operation, 7-9
  bus
    arbitration, 7-4
    commands, 7-10
    protocol, 7-9
    timing diagrams for transactions, 7-15
  bus arbitration unit, 1-17
  bus error signals, 14-5
  bus transactions
    interrupt-acknowledge transaction, 7-30
    read transactions, 7-15
    special-cycle transaction, 7-31
    transaction termination, 7-18
      master-initiated, 7-18
      retry, 7-20
      target disconnect, 7-19
      target-abort, 7-20
      target-initiated, 7-18
    write transactions, 7-17
  byte alignment, 7-14, A-2
  byte ordering, 7-2, A-1
  C/BE signals, 7-34
  configuration cycles
    configuration header, 7-25
    type 0 and 1 accesses, 7-27
  configuration space addressing, 7-13
  data transfers, 7-9
  error detection and reporting, 7-34, 14-5, 14-10
  error transactions, 7-34
  exclusive access, 7-32
  fast back-to-back transactions, 7-21
  I/O space addressing, 7-13
  little-endian mode
    transfers to I/O space, A-12
    transfers to memory space, A-9
  master-abort transaction termination, 14-11
  master-initiated transaction termination, 7-18
  memory space addressing, 7-12
  MPC8245 as PCI bus master, 7-2
  MPC8245 as PCI target, 7-3
  nonmaskable interrupt, 14-12
  overview, 1-16, 7-1
  PCI attribute signals, 1-24
  PCI commands
    C/BEn signals, 7-10
    command summary, 7-10
    encodings, 7-10
    interrupt-acknowledge transaction, 7-30
    special-cycle command, 7-31
  PCI Local Bus Specification, xlv, 4-9
  PCI special-cycle operations, 7-32
  PCI System Design Guide, xlv
  PCI/local memory buffers, 13-6
  PCI-to-ISA bridge, 14-6
  processor-to-PCI-read buffer (PRPRB), 13-4
  processor-to-PCI-write buffers (PRPWBs), 13-5
  registers, *see* Registers, PCI interface, 4-10, 7-26
  retry PCI transactions, 7-19
  signals, *see* Signals, PCI interface, 2-15, 7-3
  special cycle command, 7-32

special-cycle operations, 7-31
system control
nonmaskable interrupt, 2-31
target-abort error, 7-19, 14-12
target-disconnect, 7-3, 13-4
target-disconnect termination, 7-19
target-initiated termination, 7-20
transaction termination, 7-14
turnaround cycle, 7-14
PCI interface, *see* Interfaces, PCI interface
PCI<dult para font> interface
linear incrementing, 7-12
PCI_CLK (PCI clock), 2-37
PCI_SYNC_IN (PCI feedback clock), 2-37
PCI_SYNC_OUT (PCI clock synchronize out), 2-37
PCLSR (PCI cache line size) register, 4-14
PCSRBAR (PCSR base address) register, 4-15
PCTPR (processor current task priority) register, 11-28
Performance monitor
event selection, 16-5
uses for the performance monitor, xlv, 1-21, 16-1
Peripheral control and status *see* EUMB registers, 3-29
Peripheral logic, 5-9
block diagram, 1-15
bus operation, 1-12
DMA controller, 1-18
overview, 1-14
power management modes, 1-23
PERR (PCI parity error) signal, 2-15, 7-35, 14-5
Phase locked loop, 15-5
PI (processor initialization) register, 11-19
PIC control signals, *see* Signals, 2-25
PIC controller
block diagram, 11-3
overview, 1-20
PIC unit
features list, 11-2
internal block diagram, 11-9
interrupt protocol, 11-7
overview, 11-1
pass-through capability, 11-10
programming interface, 11-13
registers, 11-15
EICR, 11-17
external registers
IDRs (direct interrupt destination), 11-26
IVPRs (direct interrupt vector/priority), 11-26
SDRs (serial interrupt destination), 11-26
SVPRs (serial interrupt vector/priority), 11-26
FPR, 11-15
GCR, 11-16
GTBCR, 11-22
GTCCR, 11-22
GTDRs, 11-24
GTVPR, 11-23
IACK, 11-29
internal registers
IIDRs (internal interrupt destination), 11-28
IIVPRs (internal interrupt source), 11-27
non-programmable registers
IPR, 11-9
IRR, 11-10
IS, 11-10
ISR, 11-10
PCTPR, 11-28
PI, 11-19
PIC EVI (vendor identification), 11-18
SVR, 11-19
serial interrupt interface, 11-11
signals, 11-2
timers, 11-12
PICRs (processor interface configuration) registers
PICR1 register
bit settings/overview, 4-31
FLASH_WR_EN bit, 4-32, 14-8
LE_MODE (endian mode) bit, 4-32
MCP_EN bit, 2-30, 14-4
speculative PCI reads bit, 4-33
ST_GATH_EN bit, 4-32
PICR2 register
bit settings/overview, 4-33
CF_APARK bit, 4-33
CF_APHASE_WS bit, 4-34
FLASH_WR_LOCKOUT bit, 4-34, 14-8
PLL_CFG (PLL configuration) signals, 2-35
PLTR (PCI latency timer) register, 4-14
PMAA (PCI memory address attribute) signals, 2-34
Port X interface
block diagram, 6-67
overview, 6-66
Power management
doze mode, 15-5, 15-9
dynamic power management, 15-2
full-power mode, 15-4
nap mode, 7-32, 15-5, 15-10
overview, 1-22, 15-1
PCI special-cycle operations, 7-31
peripheral logic programmable power modes, 1-23, 15-9
PMCR registers
overview, 4-18
PMCR, PM bit, 4-19
power mode transition, 15-8
processor core, 15-1
programmable power modes, 1-22, 15-2
sleep mode, 4-19, 15-6, 15-11
software considerations, 15-7
Power management signals, *see* Signals

Power-on reset
  configuration pins sampled, 2-43
  intialization at power-on reset (POR), 14-3
  output signal state, 2-8
  SDRAM initialization, 6-17
PowerPC architecture
  instruction list, C-1, C-9, C-17
  instruction set, 5-19
Processor bus error status registers, 14-6
Processor control instructions, C-24
Processor core
  block diagram, 5-2
  cache implementation, 5-22
  cache units, 5-9
  description, 5-1
  differences with the MPC8240, 5-36
  dispatch unit, 5-6
  execution units, 5-7
  features list, 5-4
  floating-point unit, 5-7
  instruction queue, 5-6
  instruction timing, 5-35
  instruction unit, 5-5
  integer unit, 5-7
  memory management unit, 5-9, 5-32
  overview, 1-9, 5-1
  programming model, 5-11
Processor interface
  bus error signals, 14-4
  byte ordering, A-1
  configuration registers, 4-31
  error detection, 14-7
  local memory buffer, 13-3
  PCI buffers, 13-4
  processor bus error status register, 14-6
  programmable parameters
    parking, 4-31
    PICR1/PICR2 registers, 4-31
  registers, *see* Registers, processor interface
  shared data bus, 13-2
  unsupported bus transactions error, 14-7
Programmable power states
  doze mode, 15-5
  full-power mode (DPM enabled/disabled), 15-4
  nap mode, 15-5
  sleep mode, 15-6
PVR (processor version register), 5-19, D-16

Q

$\overline{\text{QACK}}$ (quiesce acknowledge) signal, 2-32
QBAR (queue base address) register, 9-23

R

RAM access time, 4-57
$\overline{\text{RCS}}n$ (ROM bank select) signals, 2-24
Registers
  accessing registers, 4-2-4-3
    CONFIG_ADDR register, 7-27
  address translation
    ITWR, 3-21
    LMBAR, 3-20, 3-23
    OMBAR, 3-23
    OTWR, 3-24
  address translation registers, 3-19
  configuration header summary, 4-9, 7-26
  configuration registers
    error handling registers, 2-30, 14-4
      60x/PCI error address register, 4-42
      BESR, 4-36, 4-39
      ECC single-bit error registers, 4-35
      ErrDRs, 4-38
      ErrEnRs, 4-37
      PCI bus error status register, 4-41, 7-34
      processor bus error status register, 4-41, 14-7
    memory interface
      MCCR*n*, 4-53-4-62
      memory boundary registers, 4-25, 4-30
      memory page mode register, 4-30
    MSR, D-14
    PCI interface
      command register, 4-10, 7-26
      ILR, 4-15, 4-16
      LMBAR, 4-15
      optional register, BIST control, 4-10
      PACR, 4-16, 4-17
      PBCCR, 4-14
      PCLSR, 4-14
      PCSRBAR, 4-15
      PIR, 4-13
      PLTR, 4-14
      register summary, 4-9
      status register, 4-12, 7-26-7-34
      VPICR, 4-31
    processor interface
      PICRs, 4-31-4-34
    PVR, D-12, D-16
  configuration registers, PMCR*n* power management, 4-18-4-21
  data high error capture monitor, 17-18
  data high error injection mask register, 17-16
  data low error capture monitor, 17-18
  DCMP, 5-12, D-21
  DMA registers
    BCR, 8-27
    CDAR, 8-23

DAR, 8-26
DMR, 8-18
DSR, 8-21
NDAR, 8-28
SAR, 8-25, 8-26
DMISS, 5-12, D-21
doorbell registers, 1-18
IDBR (inbound doorbell), 9-2
ECC single-bit error registers, 14-8
EUMB
local processor control and status, 3-27
peripheral control and status, 3-27, 3-29
EUMB registers
runtime, 3-25
exception handling registers
DSISR, D-19
list, D-13
SRR0/SRR1, D-20
HASH1, 5-12, D-21
HASH2, 5-12, D-21
HID0, 5-14, D-25
HID1, 5-18, D-28
HID2, 5-18, D-29
I^2C interface
I2CCR, 10-11
I2CDR, 10-14
I2CFDR, 10-8
I2CSR, 10-13
I_2O interface
hardware registers, 9-5
IFHPR, 9-17
IFQPR, 9-12, 9-13
IFTPR, 9-17
IMIMR, 9-16
IMISR, 9-13
IPHPR, 9-18
IPTPR, 9-19
MUCR, 9-22
OFHPR, 9-19
OFQPR, 9-13
OFTPR, 9-20
OMIMR, 9-11
OMISR, 9-9
OPHPR, 9-21
OPTPR, 9-21
QBAR, 9-23
register summary, 9-5
IABR, 5-12, D-21
ICMP, 5-12, D-21
IMISS, 5-12, D-21
implementation-specific registers
DCMP/ICMP, D-22
DMISS/IMISS, D-22
HASH1/HASH2, D-23
IABR, D-24
overview, 5-12
RPA, D-23
JTAG
boundary-scan registers, 17-21
bypass register, 17-21
instruction register, 17-21
status register, 17-21
memory data path error capture monitor, 17-18
memory management registers
list, D-12
SRs, D-18
miscellaneous registers
DEC, D-20
EAR (optional), D-21
list, D-13
TBL/TBU, D-10
OEA register set, D-12
optional registers
EAR, D-21
parity error capture monitor, 17-19
parity error injection mask register, 17-17
PIC unit
EICR, 11-17
external
IDRs, 11-26
IVPRs, 11-25
SDRs, 11-26
SVPRs, 11-25
FPR, 11-15
GCR, 11-16
GTBCR, 11-22
GTCCR, 11-22
GTDRs, 11-24
GTVPR, 11-23
IACK, 11-29
internal
IIDRs, 11-28
IIVPRs, 11-25
internal registers
IIDRs, 11-28
non-programmable registers
IPR, 11-9
IRR, 11-10
IS, 11-10
ISR, 11-10
PCTPR, 11-28
PI, 11-19
PIC EVI, 11-18
SVR, 11-19
PVR, 5-19, D-16
RPA, 5-12, D-21
supervisor-level
DCMP and ICMP, D-22

DEC, D-13, D-20
DMISS and IMISS, D-22
DSISR, D-19
EAR (optional), D-21
HASH1 and HASH2, D-23
IABR, D-24
MSR, D-14
PVR, D-12, D-16
RPA, D-23
SRR0/SRR1, D-20
SRs, D-18
TB, D-13
TBL/TBU, D-10
user-level
FPR0–FPR31, D-4
FPSCR, D-6
GPR0–GPR31, D-4
LR, D-9
TBL/TBU, D-20
XER, D-8
VEA register set, D-10
registers
configuration registers
memory interface
memory bank enable register, 4-29
REQ (PCI bus request) signal, 2-9, 7-4
Reservation set, lwarx/stwcx., 5-26
ROM interface, write operations, 6-60
Rotate and shift instructions, C-19
RPA (required physical address), D-24
Run-time registers, *see* EUMB registers, 3-25

S

S_CLK (serial interrupt clock) signal, 2-26
S_FRAME (serial interrupt frame) signal, 2-26
S_INT (serial interrupt stream) signal, 2-26
SAR (source address) register, 8-25, 8-26
SCL (serial clock) signal, 2-27
SDA (serial data) signal, 2-27
SDCAS (SDRAM column address strobe) signal, 2-23
SDRAM interface
address multiplexing, 6-11
block diagram, 6-6
data interface, 6-15
ECC, 6-29
JEDEC functionality, 6-19
mode-set command timing, 6-28
operation, 6-6
organizations supported, 6-9
overview, 6-6
page mode retention, 6-21
parity, 6-28
power saving modes, 6-36
power-on initialization, 6-17
programmable parameters, 6-17
registered DIMM mode, 6-31
RMW parity, 6-28
system configuration, 6-16
SDRAM_CLK (SDRAM clock outputs) signals, 2-37
SDRAM_SYNC_IN (SDRAM feedback clock) signal, 2-38
SDRAM_SYNC_OUT (SDRAM clock synchronize out), 2-37
SDRAS (SDRAM row address strobe) signal, 2-23
Segment registers
SR manipulation instructions, C-25
T bit, Glossary-2
T-bit, D-18
SERR (system error) signal, 2-16, 7-35, 14-5
Signals, 2-18, 14-5
60x processor interface
DH*n*/DL*n*, 2-21
IDSEL, 2-17
alternate functions list, 2-4
byte enable signals, 7-13
C/BE*n*, 7-14
CHKSTOP_IN, 2-31
clock
CKO, 2-38
clock signal description, 2-36
OSC_IN, 2-37
PCI_CLK, 2-37
PCI_SYNC_IN, 2-37
PCI_SYNC_OUT, 2-37
SDRAM_CLK, 2-37
SDRAM_SYNC_IN, 2-38
SDRAM_SYNC_OUT, 2-37
configuration pins sampled at reset, 2-43
cross-reference list, 2-4
DA, 2-34
debug address attribute signals, 17-2
debug signals, 2-33
HRST_CPU, 2-29
HRST_CTRL, 2-29
I^2C interface
SCL, 2-27, 10-2
SDA, 2-27, 10-2
signal summary, 2-26, 10-2
MAA, 2-33, 17-2
memory attribute signals, 1-24
memory interface
address signal mappings, 6-4
AR*n*, 2-22
AS, 2-24, 2-25
CKE, 2-23
CS*n*, 2-18
DQM*n*, 2-18

FOE, 2-24
PAR*n* (data parity/ECC), 2-22
RCS*n* (ROM bank select), 2-24
SDCAS, 2-23
SDRAS, 2-23
signal summary, 6-3
WE, 2-19
MIV, 1-25, 17-10
output signal states at power-on reset, 2-8
PCI address attribute signals, 17-3
PCI attribute signals, 1-24
PCI interface
AD*n*, 2-10, 7-13
C/BE*n*, 2-11, 7-34
description, 2-8
DEVSEL, 2-12, 7-13
FRAME, 2-13, 7-9
GNT, 2-9, 7-4
INTA Interrupt request, 2-17
IRDY, 2-14, 7-9
LOCK, 2-14
PAR (PCI parity), 2-11, 7-34
PERR, 2-15, 7-35, 14-5
REQ, 2-9, 7-4
SERR, 2-16, 7-35
STOP, 2-17, 7-14
TRDY, 2-15, 7-10
turnaround cycle, 7-14
PIC control
IRQ*n*, 2-25
L_INT, 11-2
PIC signal description, 2-25, 11-2
S_CLK, 2-26, 11-11
S_FRAME, 2-26, 11-12
S_INT, 2-26, 11-10
S_RST, 11-11
serial interrupt mode description, 2-25
signal summary, 11-2
PMAA, 2-34
power management
QACK, 2-32
signal groupings, 2-3
SMI, 2-31
system control
description, 2-28
HRESET, 14-3
MCP, 2-30
NMI, 2-31, 14-6, 14-12
SRESET, 2-29
TCK (JTAG test clock), 17-20
TDI (JTAG test data input), 17-20
TDO (JTAG test data output), 17-20
test and configuration
description, 2-35
PLL_CFG, 2-35
TCK (JTAG test clock), 2-35
TDI (JTAG test data input), 2-35
TDO (JTAG test data output), 2-36
TMS (JTAG test mode select), 2-36
TRST (JTAG test reset), 2-36
TMS (JTAG test mode select), 17-20
TRST (JTAG test reset), 17-20
Sleep mode, 1-22
description, 1-22
PMCR bit settings, 4-19
SMI (system management interrupt), 2-31
Snoop response, 13-8
SPRG0–SPRG3, conventional uses, D-19
SRESET (soft reset), 2-29
SRR0/SRR1 (status save/restore registers)
format, D-20
Status register, PCI, 7-14, 7-26, 7-34
STOP signal, 2-17, 7-14
String instructions, C-22
SVR (spurious vector) register, 11-19
Synchronization, memory synchronization instructions, C-22
System
linkage instructions, C-24
System control signals, *see* Signals
System management interrupt, 15-2
System reset exception, 14-3

T

Target-abort error, 14-12
Target-disconnect, *see* PCI interface
Target-initiated termination
description, 7-3, 7-19
PCI status register, 7-20
TCK (JTAG test clock) signal, 2-35, 17-20
TDI (JTAG test data input) signal, 2-35, 17-20
TDO (JTAG test data output) signal, 2-36, 17-20
Termination
60x, termination by TEA, 14-11
PCI
completion, 7-18
master-abort termination, 7-18, 14-11
target-disconnect, 7-3, 7-19, 13-4
target-initiated, 7-20
termination of PCI transaction, 7-18
timeout, 7-18
Test and configuration signals, *see* Signals, 2-35
Time base
computing time of day, D-11
reading the time base, D-11
TBL/TBU, D-10
writing to the time base, D-20

Timeout, PCI transaction, 7-18
TLB
  invalidate, C-25
  TLB management instructions, C-25
TMS (JTAG test mode select) signal, 2-36, 17-20
Transactions
  error transactions, 7-34
  PCI bus
    fast back-to-back transactions, 7-21
    read transactions, 7-15
    write transactions, 7-15
  PCI transaction termination, 7-18
  retry PCI transactions, 7-19
$\overline{\text{TRDY}}$ (target ready) signal, 2-15, 7-10, 7-18
TRIG_IN (watchpoint trigger in) signal, 2-32
TRIG_OUT (watchpoint trigger out) signal, 2-33
$\overline{\text{TRST}}$ (JTAG test reset) signal, 2-36
TRST (JTAG test reset) signal, 17-20
Tsi107
  aligned scalars, address modification, A-6
Turnaround cycle and PCI bus, 7-14

V

VEA (virtual environment architecture)
  register set, D-10
  time base, D-10

W

$\overline{\text{WE}}$ (write enable) signal, 2-19

X

XER register, bit definitions, D-9

Overview 1
Signal Descriptions and Clocking 2
Address Maps 3
Configuration Registers 4
Processor Core 5
Memory Interface 6
PCI Bus Interface 7
DMA Controller 8
Message Unit (I_2O) 9
I^2C Interface 10
PIC 11
DUART 12
Central Control Unit 13
Error Handling 14
Power Management 15
Performance Monitor 16
Debug Features 17
Programmable I/O and Watchpoint 18

Bit and Byte Ordering A
Initialization Example B
Instruction Set C
Processor Core Register Summary D
Revision History E

Glossary of Terms and Abbreviations GLO
Index IND

1 Overview
2 Signal Descriptions and Clocking
3 Address Maps
4 Configuration Registers
5 Processor Core
6 Memory Interface
7 PCI Bus Interface
8 DMA Controller
9 Message Unit (I_2O)
10 I^2C Interface
11 PIC
12 DUART
13 Central Control Unit
14 Error Handling
15 Power Management
16 Performance Monitor
17 Debug Features
18 Programmable I/O and Watchpoint

A Bit and Byte Ordering
B Initialization Example
C Instruction Set
D Processor Core Register Summary
E Revision History

GLO Glossary of Terms and Abbreviations
IND Index